

DRAM Management Handbook

Dynamic Memory Control Error Detection And Correction Application Support

DRAM MANAGEMENT

1991 Edition

Dynamic Memory Control

Error Detection and Correction Microprocessor Applications for the DP8408A/09A/17/18/19/28/29

Microprocessor Applications for the DP8420A/21A/22A

Microprocessor Application for the NS32CG821

Physical Dimensions/Appendices

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DRAM Management Introduction

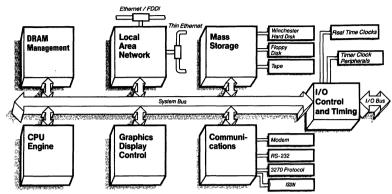
Today's large Dynamic Random Access Memory (DRAM) arrays require sophisticated high performance devices to provide timing access arbitration on board drive and control. National Semiconductor offers the broadest range of DRAM controllers with the highest "No-waitstate" performance available on the market. Controllers are available in Junction Isolated LS, Oxide Isolated ALS, and double metal CMOS for DRAMs from 64k bit through 4M bit devices, supporting memory arrays up to 64 Mbyte in size with only one LSI/VLSI device. For critical applications, National Semiconductor has developed several 16- and 32-bit Error Checking and Correction (ECC) devices to provide maximum data integrity.

The DRAM Management Handbook contains complete product information. This includes the largest number and most complete set of DRAM control and ECC products, peripheral support devices and application notes detailing complete DRAM memory system design.



National Semiconductor

Introduction to VLSI Products



National Semiconductor VLSI products include complex peripheral circuits designed to serve a variety of applications. The VLSI products are especially well suited for microcomputer and microprocessor systems such as graphics workstations, personal computers, and many others. National Semiconductor VLSI devices are fully described in a series of databooks and handbooks.

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DRAM MANAGEMENT

National Semiconductor offers the broadest range of DRAM controllers with the highest "No-waitstate" performance available on the market. For critical applications, National Semiconductor has developed several 16- and 32-bit Error Checking and Correction (ECC) devices to provide maximum data integrity.

MICROCONTROLLER

As one of the broadest cost/performance product offerings in the industry today, National's microcontrollers provide the intelligence required for high performance applications such as laser printers, ISDN terminal adapters, floppy disks and SCSI hard disks. Complete support tools are available, including applications specific software, Designer's Kits, emulators, simulators, and development systems. Whether the application demands 4-, 8- or 16-bit performance, National has the right embedded control solution.

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TL/XX/0058-1

INTERFACE

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REAL TIME CLOCKS

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Our total product system solution approach includes the hardware, software, and development support products necessary for your design. Evaluation board, in-system emulator, software development tools, and third party software are available now.



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Data Sheet Identification	Product Status	Definition
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Preliminary	First Production	This data sheet contains preliminary data, and supplementary data will be published at a later date. National Semiconductor Corporation reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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DRAM Controller Master Selection Guide

The data below is intended to highlight the key differentiable features of each DRAM Controller/Driver offered by National Semiconductor. All NSC DRAM controllers integrate onboard delay line timing, high capacitive drive, row/column muxing logic, refresh counter, row and column input latches, memory bank select logic. As a result of the family feature commonality, most devices offer pin for pin up/downward compatibility. Beyond this however, the process and design differences between the devices result in a broad selection of feature and performance options for the best system fit.

Device # & Speed Options	DRAMS Supported	Process	Тур Ісс	A.C. Specified Word Width	Max RAS to CAS Out *Fast Slow Mode Mode	Guaranteed Row Address Hold *Fast Slow Mode Mode	v _{cc}	Operating Temp Range	Package	Page No.
DP8408A A-2 A-3	16, 64k	Junction Isolated (S)	210 mA	4 Banks of 16 Bit Data w/ 6 Bit ECC ea.	105 ns/125 ns 85 ns/100 ns 120 ns/145 ns	20 ns/30 ns 12 ns/20 ns 20 ns/30 ns	+5V ±5%	0°-70°C 0°-85°C	48N 48D	1-4
DP8409A A-2 A-3	16, 64, 256k	Junction Isolated (S)	210 mA	4 Banks of 16 Bit Data w/ 6 Bit ECC ea.	105 ns/125 ns 85 ns/100 ns 120 ns/145 ns	20 ns/30 ns 12 ns/20 ns 20 ns/30 ns	+5V ±5%	0°-70°C 0°-85°C	48N 48D 68V	1-22
DP8417-80 -70	16, 64, 256k	Oxide Isolated (ALS)	150 mA	4 Banks of 16 Bit Data w/ 6 Bit ECC ea.	63 ns/80 ns 50 ns/72 ns	15 ns/25 ns 15 ns/25 ns	+5V ±10%	0°-70°C -40°-+85°C -55°-+125°C	48 N 48D 68V	1-44
DP8418-80 -70	16, 64, 256k	Oxide Isolated (ALS)	150 mA	2 Banks of 32 Bit Data w/ 7 Bit ECC ea.	63 ns/80 ns 50 ns/72 ns	15 ns/25 ns 15 ns/25 ns	+5V ±10%	0°-70°C -40°-+85°C -55°-+125°C	48 N 48D 68V	1-44
DP8419-80 -70	16, 64, 256k	Oxide Isolated (ALS)	150 mA	4 Banks of 16 Bit Data w/ 6 Bit ECC ea.	63 ns/80 ns 50 ns/72 ns	15 ns/25 ns 15 ns/25 ns	+5V ±10%	$\begin{bmatrix} 0^{\circ} - 70^{\circ}C \\ -40^{\circ} - +85^{\circ}C \\ -55^{\circ} - +125^{\circ}C \end{bmatrix}$	48 N 48D 68V	1-44
DP8420A/21A/22A DP8420V/21V/22V/T22V DP8430V/31V/32V	16, 64, 256k, 1 Mega Bit, 4 Mega Bit	2μ CMOS	5 mA	2 Banks of 32 Bit Data w/ 7 Bit ECC ea.	53 ns/63 ns 47 ns/56 ns	15 ns/25 ns 15 ns/25 ns	+5V ±10%	$\begin{bmatrix} 0^{\circ} - 70^{\circ}C \\ -40^{\circ} - +85^{\circ}C \\ -55^{\circ} - +125^{\circ}C \end{bmatrix}$	68V 84V	1-92 1-149 1-207
DP8428-80 -70	16, 64, 256k & 1 Mega Bit	Oxide Isolated (ALS)	150 mA	2 Banks of 32 Bit Data w/ 7 Bit ECC ea.	63 ns/80 ns 50 ns/72 ns	15 ns/25 ns 15 ns/25 ns	+5V ±10%	$\begin{bmatrix} 0^{\circ} - 70^{\circ}C \\ -40^{\circ} - +85^{\circ}C \\ -55^{\circ} - +125^{\circ}C \end{bmatrix}$	52D 68V	1-69
DP8429-80 -70	16, 64, 256k & 1 Mega Bit	Oxide Isolated (ALS)	150 mA	4 Banks of 16 Bit Data w/ 6 Bit ECC ea.	63 ns/80 ns 50 ns/72 ns	15 ns/25 ns 15 ns/25 ns	+5V ±10%	0°-70°C -40°-+85°C -55°-+125°C	52D 68V	1-69

*All AC valves shown factor in worst case loading (including all ouputs switching simultaneously), operating temperature, and V_{CC} supply variables. All delays assume the use of National's on-board automatic timing and delay line logic although external delay line control timing is allowed and supported.

DRAM Controller Master Selection Guide





DP8408A Dynamic RAM Controller/Driver

General Description

Dynamic memory system designs, which formerly required several support chips to drive the memory array, can now be implemented with a single IC . . . the DP8408A Dynamic RAM Controller/Driver. The DP8408A is capable of driving all 16k and 64k Dynamic RAMs (DRAMs). Since the DP8408A is a one-chip solution (including capacitive-load drivers), it minimizes propagation delay skews, the major performance disadvantage of multiple-chip memory drive and control.

The DP8408A's 6 modes of operation offer a wide selection of DRAM control capabilities. Memory access may be controlled externally or on-chip automatically; an on-chip refresh counter makes refreshing less complicated.

The DP8408A is a 48-pin DRAM Controller/Driver with 8 multiplexed address outputs and control signals. It consists of two 8-bit address latches, an 8-bit refresh counter, and control logic. All output drivers are capable of driving 500 pF loads with propagation delays of 25 ns. The DP8408A timing parameters are specified driving the typical load capacitance of 88 DRAMs, including trace capacitance.

The DP8408A has 3 mode-control pins: M2, M1, and M0, where M2 is in general REFRESH. These 3 pins select 6 modes of operation. Inputs B1 and B0 in the memory access modes (M2 = 1), are select inputs which select one of four RAS outputs. During normal access, the 8 address outputs can be selected from the Row Address Latch or the Column Address Latch. During refresh, the 8-bit on-chip refresh counter is enabled onto the address bus and in this mode all RAS outputs are selected, while CAS is inhibited.

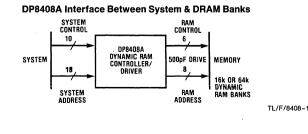
The DP8408A can drive up to 4 banks of DRAMs, with each bank comprised of 16k's, or 64k's. Control signal outputs RAS, CAS, and WE are provided with the same drive capability. Each RAS output drives one bank of DRAMs so that the four RAS outputs are used to select the banks, while CAS, WE, and the multiplexed addresses can be connected to all of the banks of DRAMs. This leaves the non-selected banks in the standby mode (less than one tenth of the operating power) with the data outputs in TRI-STATE®. Only the bank with its associated RAS low will be written to or read from.

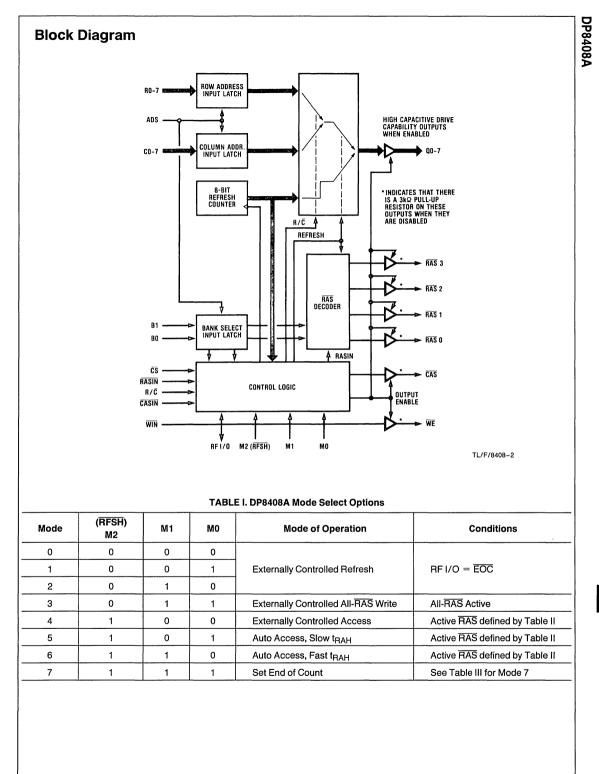
Operational Features

- All DRAM drive functions on one chip—minimizes skew on outputs, maximizes AC performance
- On-chip capacitive-load drives (specified to drive up to 88 DRAMs)
- Drive directly all 16k and 64k DRAMs
- Capable of addressing 64k and 256k words
- Propagation delays of 25 ns typical at 500 pF load
- CAS goes low automatically after column addresses are valid if desired
- Auto Access mode provides RAS, Row to Column, select, then CAS automatically and fast
- WE follows WIN unconditionally—offering READ, WRITE or READ-MODIFY-WRITE cycles
- On-chip 8-bit refresh counter with selectable End-of-Count (127 or 255)
- End-of-Count indicated by RF I/O pin going low at 127 or 255
- Low input on RF I/O resets 8-bit refresh counter
- CAS inhibited during refresh cycle
- Fall-through latches on address inputs controlled by ADS
- TRI-STATE outputs allow multi-controller addressing of memory
- Control output signals go high-impedance logic "1" when disabled for memory sharing
- Power-up: counter reset, control signals high, address outputs TRI-STATE, and End-of-Count set to 127

Mode Features

- 6 modes of operation: 3 access, 1 refresh, and 2 set-up
- 2 externally controlled modes: 1 access (Mode 4) and 1 refresh (Modes 0, 1, 2)
- 2 auto-access modes $\overline{RAS} \rightarrow R/\overline{C} \rightarrow \overline{CAS}$ automatic, with $t_{RAH} = 20$ or 30 ns minimum (Modes 5, 6)
- Externally controlled All-RAS Access modes for memory initialization (Mode 3)
- End-of-Count value of Refresh Counter set by B1 and B0 (Mode 7)



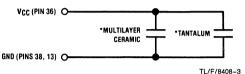


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Pin Definitions

 V_{CC} , GND, GND— $V_{CC}=5V\pm5\%$. The three supply pins have been assigned to the center of the package to reduce voltage drops, both DC and AC. There are also two ground pins to reduce the low level noise. The second ground pin is located two pins from V_{CC}, so that decoupling capacitors can be inserted directly next to these pins. It is important to adequately decouple this device, due to the high switching currents that will occur when all 8 address bits change in the same direction simultaneously. A recommended solution would be a 1 μ F multilayer ceramic capacitor in parallel with a low-voltage tantalum capacitor, both connected as close as possible to pins 36 and 38 to reduce lead inductance. See *Figure* below.



*Capacitor values should be chosen depending on the particular application.

R0-R7: Row Address Inputs.

C0-C7: Column Address Inputs.

Q0-Q7: Multiplexed Address Outputs—Selected from the Row Address Input Latch, the Column Address Input Latch, or the Refresh Counter.*

RASIN: Row Address Strobe Input—Enables selected RAS_n output when M2 (RFSH) is high, or all RAS_n outputs when RFSH is low.

R/C: Row/Column Select Input—Selects either the row or column address input latch onto the output bus.

CASIN: Column Address Strobe Input—Inhibits CAS output when high in Modes 4 and 3. In Mode 6 it can be used to prolong CAS output.

ADS: Address (Latch) Strobe Input—Row Address, Column Address, and Bank Select Latches are fall-through with ADS high; Latches on high-to-low transition.

CS: Chip Select Input—TRI-STATE the Address Outputs and puts the control signal into a high-impedance logic "1" state when high (except in Mode 0); enables all outputs when low.

M0, M1, M2: Mode Control Inputs—These 3 control pins determine the 6 major modes of operation of the DP8408A as depicted in Table I.

RF I/O—The I/O pin functions as a Reset Counter Input when set low from an external open-collector gate, or as a flag output. The flag goes active-low when M2 = 0 and the End-of-Count output is at 127 or 255 (see Table III).

WIN: Write Enable Input.

WE: Write Enable Output—Buffered output from WIN.*

CAS: Column Address Strobe Output—In Modes 5 and 6, CAS goes low following valid column address. In Modes 3 and 4, it transitions low after R/\overline{C} goes low, or follows CASIN going low if R/\overline{C} is already low. CAS is high during refresh.*

RAS 0–3: Row Address Strobe Outputs—Selects a memory bank decoded from B1 and B0 (see Table II), if RFSH is high. If RFSH is low, all banks are selected.*

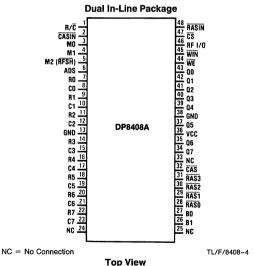
B0, B1: Bank Select Inputs—Strobed by ADS. Decoded to enable one of the RAS outputs when RASIN goes low. Also used to define End-of-Count in Mode 7 (Table III).

*These outputs may need damping resistors to prevent overshoot, undershoot. See AN-305 "Precautions to Take When Driving Memories."

TABLE	II. Memory	/ Bank	Decode

	Select I by ADS)	Enabled RAS _n		
B1	BO			
0	0	RAS ₀		
0	1	RAS ₁		
1	0	RAS ₂		
1	1	RAS ₃		

Connection Diagram



Order Number DP8408AD, DP8408AN or DP8408AN-3 See NS Package Number D48A or N48A

Conditions for all Modes

INPUT ADDRESSING

The address block consists of a row-address latch, a columnaddress latch, and a resettable refresh counter. The address latches are fall-through when ADS is high and latch when ADS goes low. If the address bus contains valid addresses until after the valid address time, ADS can be permanently high. Otherwise ADS must go low while the addresses are still valid.

In normal memory access operation, $\overline{\text{RASIN}}$ and R/C are initially high. When the address inputs are enabled into the address latches, the row addresses appear on the Q outputs. The address strobe also inputs the bank-select address, (B0 and B1). If $\overline{\text{CS}}$ is low, all outputs are enabled. When $\overline{\text{CS}}$ is transitioned high, the address outputs go TRI-STATE and the control outputs first go high through a low impedance, and then are held by an on-chip high impedance. This allows output paralleling with other DP8408As for multi-addressing. All outputs go active about 50 ns after the chip is selected again. If $\overline{\text{CS}}$ is high, and a refresh cycle begins, all the outputs become active until the end of the refresh cycle.

DRIVE CAPABILITY

The DP8408A has timing parameters that are specified with up to 600 pF loads. In a typical memory system this is equivalent to about 88, 5V-only DRAMs, with trace lengths kept to a minimum. Therefore, the chip can drive four banks each of 16 or 22 bits, or two banks of 32 or 39 bits, or one bank of 64 or 72 bits.

Less loading will slightly reduce the timing parameters, and more loading will increase the timing parameters, according to the graph of *Figure 6*. The AC performance parameters are specified with the typical load capacitance of 88 DRAMs. This graph can be used to extrapolate the variations expected with other loading.

Because of distributed trace capacitance and inductance and DRAM input capacitance, current spikes can be created, causing overshoots and undershoots at the DRAM inputs that can change the contents of the DRAMs or even destroy them. To remove these spikes, a damping resistor (low inductance, carbon) can be inserted between the DP8408A driver outputs and the DRAMs, as close as possible to the DP8408A. The values of the damping resistors may differ between the different control outputs; RAS's CAS, Q's and WE. The damping resistors should be determined by the first prototypes (not wire-wrapped due to larger distributed capacitance and inductance). The best values for the damping resistors are the critical values giving a critically damped transition on the control outputs. Typical values for the damping resistors will be between 15Ω and 100 Ω , the lower the loading the higher the value. (For more information, see AN-305 "Precautions to Take When Driving Memories.")

DP8408A DRIVING ANY 16K OR 64K DRAMS

The DP8408A can drive any 16k or 64k DRAMs. All 16k DRAMs are basically the same configuration, including the newer 5V-only version. Hence, in most applications, different manufacturers' DRAMs are interchangeable (for the same supply-rail chips), and the DP8408A can drive all 16k DRAMS (see *Figure 1a*).

There are three basic configurations for the 5V-only 64k DRAMs: a 128-row by 512-column array with an on-RAM refresh counter, a 128-row by 512-column array with no on-RAM refresh counter, and a 256-row by 256-column array with no on-RAM refresh counter. The DP8408A can drive all three configurations, and at the same time allows them all to be interchangeable (as shown in *Figure 1b* and *1c*), providing maximum flexibility in the choice of DRAMs. Since the 8-bit on-chip refresh counter can be used as a 7-bit refresh counter for the 128-row configuration, or as an 8-bit refresh counter (if present) is never used. As long as 128 rows are refreshed every 2 ms (i.e. 256 rows in 4 ms) all DRAM types are correctly refreshed.

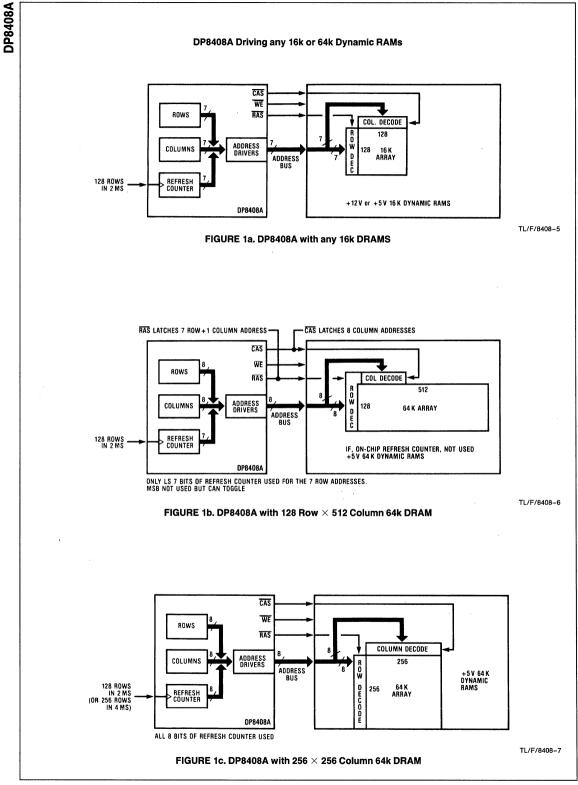
When the DP8408A is in a refresh mode, the RF I/O pin indicates that the on-chip refresh counter has reached its end-of-count. This end-of-count is selectable as 127 or 255 to accommodate 16k or 64k DRAMs, respectively. Although the end-of-count may be chosen to be either of these values, the counter is not reset and always counts to 255 before rolling over to zero.

READ, WRITE AND READ-MODIFY-WRITE CYCLES

The output signal, \overline{WE} , determines what type of memory access cycle the memory will perform. If \overline{WE} is kept high while \overline{CAS} goes low, a read cycle occurs. If \overline{WE} goes low before \overline{CAS} goes low, a write cycle occurs and data at DI (DRAM input data) is written into the DRAM as \overline{CAS} goes low. If \overline{WE} goes low later than t_{CWD} after \overline{CAS} goes low, first a read occurs and DO (DRAM output data) becomes valid; then data DI is written into the same address in the DRAM when \overline{WE} goes low. In this read-modify-write case, DI and DO cannot be linked together. The type of cycle is therefore controlled by \overline{WE} , which follows \overline{WIN} .

POWER-UP INITIALIZE

When V_{CC} is first applied to the DP8408A, an initialize pulse clears the refresh counter, the internal control flip-flops, and sets the End-of-Count of the refresh counter to 127 (which may be changed via Mode 7). As V_{CC} increases to about 2.3V, it holds the output control signals at a level of one Schottky diode-drop below V_{CC}, and the output address to TRI-STATE. As V_{CC} increases above 2.3V, control of these outputs is granted to the system.



Functional Mode Descriptions

Note: All delay parameters stated in text refer to the DP8408A. Substitute the respective delay numbers for the DP8408-2 or DP8408-3 when using these devices.

MODES 0, 1, 2 — EXTERNALLY CONTROLLED REFRESH

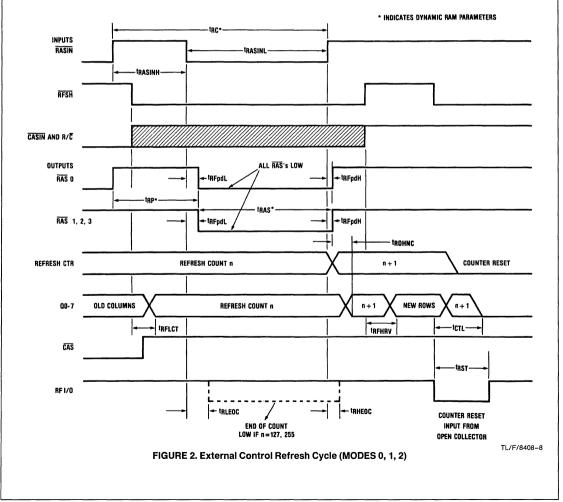
In this mode, the input address latches are disabled from the address outputs and the refresh counter is enabled. When $\overline{\text{RAS}}$ occurs, the enabled row in the DRAM is refreshed. In the Externally Controlled Refresh mode, all $\overline{\text{RAS}}$ outputs are enabled following $\overline{\text{RASIN}}$, and $\overline{\text{CAS}}$ is inhibited. This refreshes the same row in all four banks. The refresh counter increments when either $\overline{\text{RASIN}}$ or $\overline{\text{RFSH}}$ goes low-to-high after a refresh. RF I/O goes low when the count is 127 or 255, as set by End-of-Count (see Table III), with $\overline{\text{RASIN}}$ and $\overline{\text{RFSH}}$ goes. RF I/O is set low through an external open-collector driver.

During refresh, \overrightarrow{RASIN} and RFSH must be skewed transitioning low such that the refresh address is valid on the address outputs of the controller before the \overrightarrow{RAS} outputs go low. The amount of time that RFSH should go low before \overrightarrow{RASIN} does depends on the capacitive loading of the address and $\overline{\text{RAS}}$ lines. For the load specified in the switching characteristics of this data sheet, 10 ns is sufficient. Refer to *Figure 2*.

To perform externally controlled burst refresh, RASIN is toggled while RFSH is held low. The refresh counter increments with RASIN going low to high, so that the DRAM rows are refreshed in succession by RASIN going high to low.

MODE 3 — EXTERNALLY CONTROLLED ALL-RAS WRITE

This mode is useful at system initialization. The memory address is provided by the processor, which also performs the incrementing. All four TAS outputs follow TASIN (supplied by the processor), strobing the row address into the DRAMs. R/C can now go low, while CASIN may be used to control CAS (as in the Externally Controlled Access mode), so that CAS strobes the column address contents into the DRAMs. At this time WE should be low, causing the data to be written into all four banks of DRAMs. At the end of the write cycle, the input address is incremented and latched by the DP8408A for the next write cycle.



MODE 4 -- EXTERNALLY CONTROLLED ACCESS

This mode facilitates externally controlling all access-timing parameters associated with the DRAMs. The application of modes 0 and 4 are shown in *Figure 3*.

Output Address Selection

Refer to *Figure 4a.* With M2 (RFSH) and R/ \overline{C} high, the row address latch contents are transferred to the multiplexed address bus output Q0–Q7, provided \overline{CS} is set low. The column address latch contents are output after R/ \overline{C} goes low. RASIN can go low after the row addresses have been set up on Q0–Q7. This selects one of the RAS outputs, strobing the row address on the Q outputs into the desired bank of memory. After the row-address hold-time of the DRAMS, R/ \overline{C} can go low so that about 40 ns later column addresses appear on the Q outputs.

Automatic CAS Generation

In a normal memory access cycle \overline{CAS} can be derived from inputs \overline{CASIN} or R/ \overline{C} . If \overline{CASIN} is high, then R/ \overline{C} going low switches the address output drivers from rows to columns. \overline{CASIN} then going low causes \overline{CAS} to go low approximately 40 ns later, allowing \overline{CAS} to occur at a predictable time (see *Figure 4b*). If \overline{CASIN} is low when R/ \overline{C} goes low, \overline{CAS} will be automatically generated, following the row to column transition by about 20 ns (see *Figure 4a*). Most DRAMs have a column address set-up time before \overline{CAS} (t_{ASC}) of 0 ns or -10 ns. In other words, a t_{ASC} greater than 0 ns is safe. This feature reduces timing-skew problems, thereby improving access time of the system.

Fast Memory Access

AC parameters t_{DIF1} , t_{DIF2} may be used to determine the minimum delays required between \overline{RASIN} , R/\overline{C} , and \overline{CASIN} (see Application Brief 9; "Fastest DRAM Access Mode").

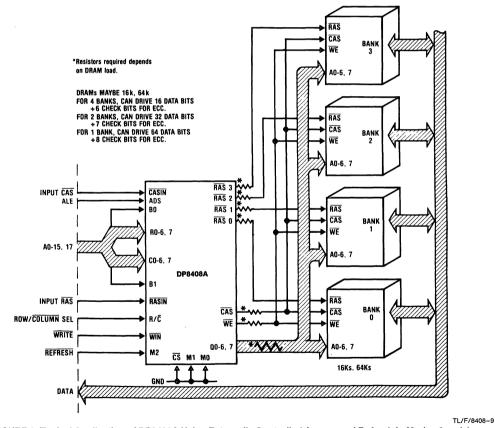
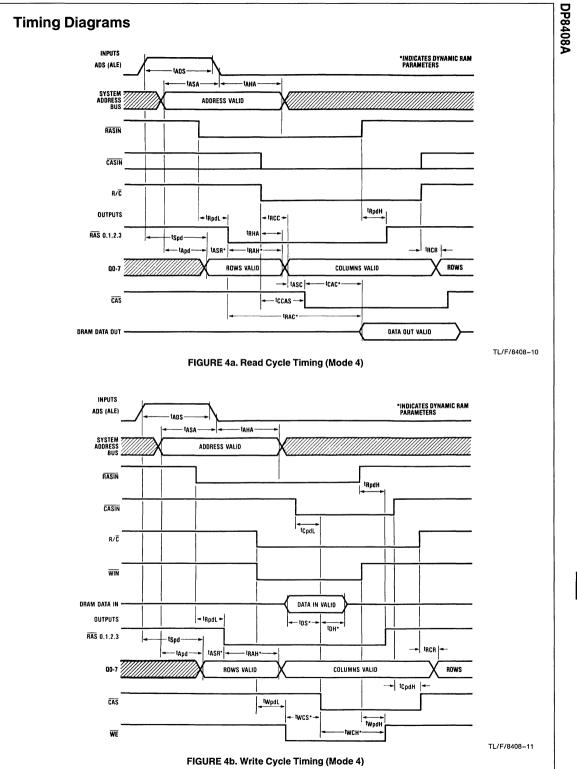


FIGURE 3. Typical Application of DP8408A Using Externally Controlled Access and Refresh in Modes 0 and 4



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MODE 5-AUTOMATIC ACCESS

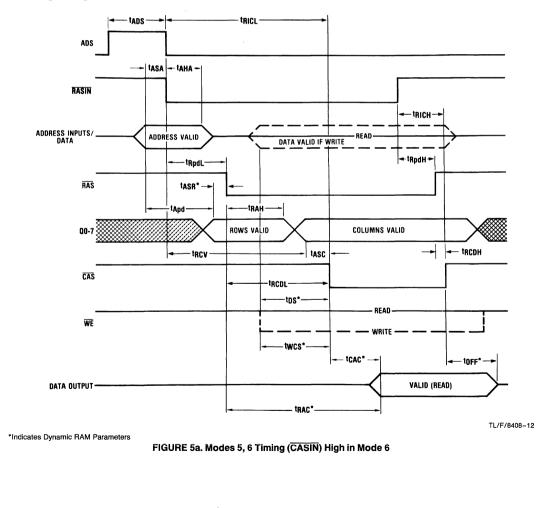
The Auto Access mode has two advantages over the Externally Controlled Access mode, due to the fact that all outputs except WE are initiated from RASIN. First, inputs R/ \overline{C} and \overline{CASIN} are unnecessary. Secondly, because the output control signals are derived internally from one input signal (RASIN), timing-skew problems are reduced, thereby reducing memory access time substantially or allowing use of slower DRAMs. The automatic access features of Mode 5 (and Mode 6) of the DP8408A make DRAM accessing appear essentially "static".

AUTOMATIC ACCESS CONTROL

The major disadvantage of DRAMs compared to static RAMs is the complex timing involved. First, a RAS must occur with the row address previously set up on the multiplexed address bus. After the row address has been held for t_{RAH} , (the Row-Address hold-time of the DRAM), the column address is set up and then \overline{CAS} occurs. This is all performed automatically by the DP8408A in this mode.

Provided the input address is valid as ADS goes low, \overrightarrow{RASIN} can go low any time after ADS. This is because the selected \overrightarrow{RAS} occurs typically 27 ns later, by which time the row address is already valid on the address output of the DP8408A. The Address Setup-Up time (t_{ASR}), is 0 ns on most DRAMs. The DP8408A in this mode (with ADS and \overrightarrow{RASIN} edges simultaneously applied) produces a minimum t_{ASR} of 0 ns. This is true provided the input address was valid t_{ASA} before ADS went low (see *Figure 5a*).

Next, the row address is disabled after t_{RAH} (30 ns minimum); in most DRAMs, t_{RAH} minimum is less than 30 ns. The column address is then set up and t_{ASC} later, \overline{CAS}



Timing Diagram

occurs. The only other control input required is $\overline{\text{WIN}}$. When a write cycle is required, $\overline{\text{WIN}}$ must go low at least 30 ns before $\overline{\text{CAS}}$ is output low.

This gives a total typical delay from: input address valid to $\overline{\text{RASIN}}$ (15 ns); to $\overline{\text{RAS}}$ (27 ns); to rows held (50 ns); to columns valid (25 ns); to $\overline{\text{CAS}}$ (23 ns) = 140 ns (that is, 125 ns from $\overline{\text{RASIN}}$. All of these typical figures are for heavy capacitive loading, of approximately 88 DRAMs. This mode is therefore extremely fast. The external timing is greatly simplified for the memory system designer: the only system signal required is $\overline{\text{RASIN}}$.

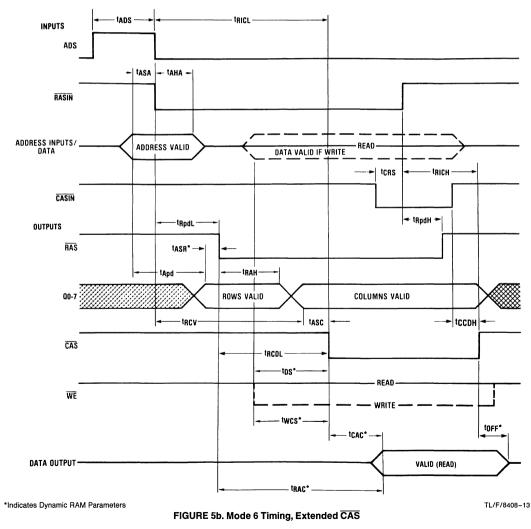
MODE 6—FAST AUTOMATIC ACCESS

The Fast Access mode is similar to Mode 5, but has a faster $t_{\hbox{\scriptsize RAH}}$ of 20 ns, minimum. It therefore can only be used with

fast 16k or 64k DRAMs (which have a t_{RAH} of 10 ns to 15 ns) in applications requiring fast access times; RASIN to CAS is typically 105 ns.

In this mode, the R/\overline{C} pin is not used, but \overline{CASIN} is used to allow an extended \overline{CAS} after \overline{RAS} has already terminated. Refer to *Figure 5b*. This is desirable with fast cycle-times where \overline{RAS} has to be terminated as soon as possible before the next \overline{RAS} begins (to meet the precharge time, or t_{RP} , requirements of the DRAM). \overline{CAS} may then be held low by \overline{CASIN} to extend the data output valid time from the DRAM to allow the system to read the data. \overline{CASIN} subsequently going high ends \overline{CAS} . If this extended \overline{CAS} is not required, \overline{CASIN} should be set high in Mode 6.

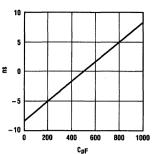
Timing Diagram



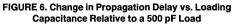
MODE 7-SET END-OF-COUNT

The End-of-Count can be externally selected in Mode 7, using ADS to strobe in the respective value of B1 and B0 (see Table III). With B1 and B0 the same EOC is 127; with B1=0 and B0=1, EOC is 255; and with B1=1 and B0=0, EOC is 127. This selected value of EOC will be used until the next Mode 7 selection. At power-up the EOC is automatically set to 127 (B1 and B0 set to 11).

TABLE III. Mode 7					
	Select d by ADS)	End of Count Selected			
B1	B0	Celebieu			
0	0	127			
0	1	255			
1	0	127			
1	1	127			



TL/F/8408-14



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage, V _{CC}	7.0V
Storage Temperature Range	-65°C to +150°C
Input Voltage	5.5V
Output Current	150 mA
Lead Temperature (Soldering, 10 sec)	300°C
*Derate cavity package 23.6 mW/°C above 25°C, 22.7 mW/°C above 25°C.	derate molded package

Maximum Power Dissipation* at 25°C	
Cavity Package	3542 mW
Molded Package	2833 mW

Operating Conditions

		Min	Мах	Units	
V _{CC}	Supply Voltage	4.75	5.25	v	
TA	Ambient Temperature	0	+70	°C	

Electrical Characteristics $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 6)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _C	Input Clamp Voltage	$V_{CC} = Min., I_C = -12 mA$		-0.8	-1.2	v
l _{IH1}	Input High Current for ADS, R/\overline{C} only	$V_{IN} = 2.5V$		2.0	100	μA
I _{IH2}	Input High Current for All Other Inputs*	$V_{IN} = 2.5V$		1.0	50	μΑ
I _I RSI	Output Load Current for RF I/O	V _{IN} = 0.5V, Output High		-1.5	-2.5	mA
II CTL	Output Load Current for RAS, CAS, WE	V _{IN} = 0.5V, Chip Deselect		-1.5	-2.5	mA
l _{IL1}	Input Low Current for ADS, R/C only	$V_{IN} = 0.5V$	-	-0.1	-1.0	mA
I _{IL2}	Input Low Current for All Other Inputs*	V _{IN} = 0.5V		-0.05	-0.5	mA
VIL	Input Low Threshold				0.8	V
VIH	Input High Threshold		2.0			V
V _{OL1}	Output Low Voltage*	$I_{OL} = 20 \text{ mA}$		0.3	0.5	v
V _{OL2}	Output Low Voltage for RF I/O	$I_{OL} = 10 \text{ mA}$		0.3	0.5	V
V _{OH1}	Output High Voltage*	$I_{OH} = -1 \text{ mA}$	2.4	3.5		V
V _{OH2}	Output High Voltage for RF I/O	I _{OH} = - 100 μA	2.4	3.5		v
I _{1D}	Output High Drive Current*	V _{OUT} = 0.8V (Note 3)		-200		mA
loD	Output Low Drive Current*	V _{OUT} = 2.7V (Note 3)		200		mA
I _{OZ}	TRI-STATE Output Current (Address Outputs)	$\begin{array}{l} 0.4 V \leq V_{OUT} \leq 2.7 V, \\ \overline{\mathrm{CS}} = 2.0 V, \text{Mode 4} \end{array}$	-50	1.0	50	μΑ
lcc	Supply Current	V _{CC} = Max.		210	285	mA

Switching Characteristic DP8408A/DP8408-3

 $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each of 88 DRAMs including trace capacitance. These values are: Q0–Q7, C_L = 500 pF; RAS0–RAS3, C_L = 150 pF; WE, C_L = 500 pF; CAS, C_L = 600 pF, unless otherwise noted. See *Figure 7* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k Ω unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Access Parameter	Conditions		8408A	·		8408-3	3	Units
Cymbol	Access rarameter	N		Тур	Max	Min	Тур	Max	Office
t _{RICL}	RASIN to CAS Output Delay (Mode 5)	Figure 5a	95	125	160	95	125	185	ns
t _{RICL}	RASIN to CAS Output Delay (Mode 6)	Figures 5a, 5b	80	105	140	80	105	160	ns
t _{RICH}	RASIN to CAS Output Delay (Mode 5)	Figure 5a	40	48	60	40	48	70	ns
t _{RICH}	RASIN to CAS Output Delay (Mode 6)	Figures 5a, 5b	50	63	80	50	63	95	ns
t _{RCDL}	RAS to CAS Output Delay (Mode 5)	Figure 5a		98	125		98	145	ns
t _{RCDL}	RAS to CAS Output Delay (Mode 6)	Figures 5a, 5b		78	105		78	120	ns
t _{RCDH}	RAS to CAS Output Delay (Mode 5)	Figure 5a		27	40		27	40	ns
t _{RCDH}	RAS to CAS Output Delay (Mode 6)	Figure 5a		40	65		40	65	ns
t _{CCDH}	CASIN to CAS Output Delay (Mode 6)	Figure 5b	40	54	70	40	54	80	ns
t _{RAH}	Row Address Hold Time (Mode 5)	Figure 5a	30			30			ns
t _{RAH}	Row Address Hold Time (Mode 6)	Figures 5a, 5b	20			20			ns
t _{ASC}	Column Address Setup Time (Mode 5)	Figure 5a	8			8			ns
t _{ASC}	Column Address Setup Time (Mode 6)	Figures 5a, 5b	6			6			ns
t _{RCV}	RASIN to Column Address Valid (Mode 5)	Figure 5a		90	120		90	140	ns
t _{RCV}	RASIN to Column Address Valid (Mode 6)	Figures 5a, 5b		75	105		75	120	ns
t _{RPDL}	RASIN to RAS Delay	Figures 4a, 4b, 5a, 5b	20	27	35	20	27	40	ns
t _{RPDH}	RASIN to RAS Delay	Figures 4a, 4b, 5a, 5b	15	23	32	15	23	37	ns
t _{APDL}	Address Input to Output Low Delay	Figures 4a, 4b, 5a, 5b		25	40		25	46	ns
t _{APDH}	Address Input to Output High Delay	Figures 4a, 4b, 5a, 5b		25	40		25	46	ns
tSPDL	Address Strobe to Address Output Low	Figures 4a, 4b		40	60		40	70	ns
tSPDH	Address Strobe to Address Output High	Figures 4a, 4b		40	60		40	70	ns
t _{ASA}	Address Setup Time to ADS	Figures 4a, 4b, 5a, 5b	15			15			ns
t _{AHA}	Address Hold Time from ADS	Figures 4a, 4b, 5a, 5b	15			15			ns
t _{ADS}	Address Strobe Pulse Width	Figures 4a, 4b, 5a, 5b	30			30			ns
twPDL	WIN to WE Output Delay	Figure 4b	15	25	30	15	25	35	ns
twpdh	WIN to WE Output Delay	Figure 4b	15	30	60	15	30	70	ns
t _{CRS}	CASIN Setup Time to RASIN High (Mode 6)	Figure 5b	35			35			ns
t _{CPDL}	$\overline{\text{CASIN}}$ to $\overline{\text{CAS}}$ Delay (R/ $\overline{\text{C}}$ low in Mode 4)	Figure 4b	32	41	68	32	41	77	ns
t _{CPDH}	CASIN to CAS Delay	Figure 4b	25	39	50	25	39	60	ns
t _{RCC}	Column Select to Column Address Valid	Figure 4a		40	58		40	67	ns
t _{RCR}	Row Select to Row Address Valid	Figures 4a, 4b		40	58		40	67	ns
t _{RHA}	Row Address Held from Column Select	Figure 4a	10			10			ns
t _{CCAS}	R/\overline{C} Low to \overline{CAS} Low (Mode 4 Auto \overline{CAS})	Figure 7a		65	90				ns

Switching Characteristics DP8408A/DP8408-3 (Continued)

 $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each of 88 DRAMs including trace capacitance. These values are: Q0–Q7, $C_L = 500 \text{ pF}$; $\overline{RAS0}$ – $\overline{RAS3}$, $C_L = 150 \text{ pF}$; \overline{WE} , $C_L = 500 \text{ pF}$; \overline{CAS} , $C_L = 600 \text{ pF}$, unless otherwise noted. See *Figure 7* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k Ω unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Access Parameter	Conditions	8408A				Units		
Symbol	Access Farameter	Conditions	Min	Тур	Max	Min	Тур	Max	Units
t _{DIF1}	Maximum (t _{RPDL} - t _{RHA})	See Mode 4 description			13			18	ns
t _{DIF2}	Maximum (t _{RCC} - t _{CPDL})	See Mode 4 description			13			18	ns
Refresh Pa	arameter								
t _{RC}	Refresh Cycle Period	Figure 2	100			100			ns
t _{RASINL} , H	Pulse Width of RASIN during Refresh	Figure 2	50			50			ns
t _{RFPDL}	RASIN to RAS Delay during Refresh	Figure 2	35	50	70	35	50	80	ns
t _{RFPDH}	RASIN to RAS Delay during Refresh	Figure 2	30	40	55	30	40	65	ns .
t _{RFLCT}	RFSH Low to Counter Address Valid	$\overline{\text{CS}} = X$, Figure 2		47	60		47	70	ns
t _{RFHRV}	RFSH High to Row Address Valid	Figure 2		45	60		45	70	ns
t ROHNC	RAS High to New Count Valid	Figure 2		30	55		30	55	ns
t _{RLEOC}	RASIN Low to End-of-Count Low	C _L = 50 pF, <i>Figure 2</i>			80			80	ns
t _{RHEOC}	RASIN High to End-of-Count High	C _L = 50 pF, <i>Figure 2</i>			80			80	ns
t _{RST}	Counter Reset Pulse Width	Figure 2	70			70			ns
^t CTL	RF I/O Low to Counter Outputs All Low	Figure 2			100			100	ns
TRI-STATE	E Parameter								
^t zн	CS Low to Address Output High from Hi-Z	<i>Figure 8</i> R1 = 3.5k, R2 = 1.5k		35	60		35	60	ns
t _{HZ}	CS High to Address Output Hi-Z from High	C _L = 15 pF, <i>Figure 8</i> R2 = 1k, S1 open		20	40		20	40	ns
t _{ZL}	CS Low to Address Output Low from Hi-Z	<i>Figure 8</i> R1 = 3.5k, R2 = 1.5k		35	60		35	60	ns
t _{LZ}	CS High to Address Output Hi-Z from Low	C _L = 15 pF, <i>Figure 8</i> R1 = 1k, S2 open		25	50		25	50	ns
t _{HZH}	CS Low to Control Output High from Hi-Z High	Figure 8 R2 = 750 Ω , S1 open		50	80		50	80	ns
tннz	CS High to Control Output Hi-Z High from High	$C_L = 15 \text{ pF}, Figure 8$ R2 = 750 Ω , S1 open	40 7		75		40	75	ns
t _{HZL}	CS Low to Control Output Low from Hi-Z High	<i>Figure 8</i> S1, S2 open		45 75			45	75	ns
t _{LHZ}	CS High to Control Output Hi-Z High from Low	$C_L = 15 \text{ pF}, Figure 8,$ R2 = 750 Ω , S1 open		50	80		50	80	ns

DP8408A

Switching Characteristics DP8408-2

 $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5, 7). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMS including trace capacitance. These values are: Q0–Q7, $C_L = 500 \text{ pF}$; $\overline{\text{RAS0-RAS3}}$, $C_L = 150 \text{ pF}$, $\overline{\text{WE}}$, $C_L = 500 \text{ pF}$; $\overline{\text{CAS}}$, $C_L = 600 \text{ pF}$, unless otherwise noted. See *Figure 7* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k\Omega unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Access Parameter	Conditions		Units		
			Min	Тур	Max	
t _{RICL}	RASIN to CAS Output Delay (Mode 5)	Figure 5a		100	130	ns
t _{RICL}	RASIN to CAS Output Delay (Mode 6)	Figures 5a, 5b	65	90	115	ns
t _{RICH}	RASIN to CAS Output Delay (Mode 5)	Figure 5a	40	48	60	ns
^t RICH	RASIN to CAS Output Delay (Mode 6)	Figures 5a, 8b	50	63	80	ns
t _{RCDL}	RAS to CAS Output Delay (Mode 5)	Figure 5a		75	100	ns
t _{RCDL}	RAS to CAS Output Delay (Mode 6)	Figures 5a, 5b		65	85	ns
^t RCDH	RAS to CAS Output Delay (Mode 5)	Figure 5a		27	40	ns
t _{RCDH}	RAS to CAS Output Delay (Mode 6)	Figure 5a		40	65	ns
t _{CCDH}	CASIN to CAS Output Delay (Mode 6)	Figure 5b	40	54	70	ns
t _{RAH}	Row Address Hold Time (Mode 5) (Note 7)	Figure 5a	20			ns
t _{RAH}	Row Address Hold Time (Mode 6) (Note 7)	Figures 5a, 5b	12			ns
tASC	Column Address Setup Time (Mode 5)	Figure 5a	3			ns
tASC	Column Address Setup Time (Mode 6)	Figures 5a, 8b	3			ns
t _{RCV}	RASIN to Column Address Valid (Mode 5)	Figure 5a		80	105	ns
tRCV	RASIN to Column Address Valid (Mode 6)	Figures 5a, 5b		70	90	ns
tRPDL	RASIN to RAS Delay	Figures 4a, 4b, 5a, 5b	20	27	35	ns
t _{RPDH}	RASIN to RAS Delay	Figures 4a, 4b, 5a, 5b	15	23	32	ns
tAPDL	Address Input to Output Low Delay	Figures 4a, 4b, 5a, 5b		25	40	ns
t _{APDH}	Address Input to Output High Delay	Figures 4a, 4b, 5a, 5b		25	40	ns
tSPDL	Address Strobe to Address Output Low	Figures 4a, 4b		40	60	ns
tSPDH	Address Strobe to Address Output High	Figures 4a, 4b		40	60	ns
t _{ASA}	Address Set-up Time to ADS	Figures 4a, 4b, 5a, 5b	15			ns
t _{AHA}	Address Hold Time from ADS	Figures 4a, 4b, 5a, 5b	15			ns
tADS	Address Strobe Pulse Width	Figures 4a, 4b, 5a, 5b	30			ns
tWPDL	WIN to WE Output Delay	Figure 4b	15	25	30	ns
tWPDH	WIN to WE Output Delay	Figure 4b	15	30	60	ns
tCRS	CASIN Set-up Time to RASIN High (Mode 6)	Figure 5b	35			ns
tCPDL	$\overline{\text{CASIN}}$ to $\overline{\text{CAS}}$ Delay (R/ $\overline{\text{C}}$ low in Mode 4)	Figure 4b	32	41	58	ns
t _{CPDH}	$\overline{\text{CASIN}}$ to $\overline{\text{CAS}}$ Delay (R/ $\overline{\text{C}}$ low in Mode 4)	Figure 4b	25	39	50	ns
tRCC	Column Select to Column Address Valid	Figure 4a		40	58	ns
t _{RCR}	Row Select to Row Address Valid	Figures 4a, 4b		40	58	ns
t _{RHA}	Row Address Held from Column Select	Figure 4a	10			ns
tCCAS	R/\overline{C} Low to \overline{CAS} Low (Mode 4 Auto \overline{CAS})	Figure 7a		55	75	ns

 $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5, 7). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMS including trace capacitance. These values are: Q0–Q7, C_L = 500 pF; $\overline{RAS0}$ - $\overline{RAS3}$, C_L = 150 pF, \overline{WE} , C_L = 500 pF; \overline{CAS} , C_L = 600 pF, unless otherwise noted. See *Figure 7* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k Ω unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Access Parameter	Conditions		Units			
Symbol	Access Falameter	Conditions	Min	Тур	Max		
t _{DIF1}	Maximum (t _{RPDL} t _{RHA})	See Mode 4 description			13	ns	
t _{DIF2}	Maximum (t _{RCC} - t _{CPDL})	See Mode 4 description			13	ns	
Refresh Par	rameter						
t _{RC}	Refresh Cycle Period	Figure 2	100			ns	
tRASINL, H	Pulse Width of RASIN during Refresh	Figure 2	50			ns	
t _{RFPDL}	RASIN to RAS Delay during Refresh	Figure 2	35	50	70	ns	
t _{RFPDH}	RASIN to RAS Delay during Refresh	Figure 2	30	40	55	ns	
t _{RFLCT}	RFSH Low to Counter Address Valid	$\overline{\text{CS}} = X$, Figure 2		47	60	ns	
tRFHRV	RFSH High to Row Address Valid	Figure 2		45	60	ns	
t _{ROHNC}	RAS High to New Count Valid	Figure 2		30	55	ns	
^t RLEOC	RASIN Low to End-of-Count Low	C _L = 50 pF, <i>Figure 2</i>			80	ns	
t _{RHEOC}	RASIN High to End-of-Count High	$C_L = 50 \text{ pF}, Figure 2$			80	ns	
tRST	Counter Reset Pulse Width	<i>Figure 2</i> 70				ns	
1 _{CTL}	RF I/O Low to Counter Outputs All Low	Figure 2			100	ns	
TRI-STATE	Parameter						
^t zH	CS Low to Address Output High from Hi-Z	-Z <i>Figures 9, 12</i> R1 = 3.5k, R2 = 1.5k		35	60	ns	
t _{HZ}	CS High to Address Output Hi-Z from High	C _L = 15 pF, <i>Figures 9, 12</i> R2 = 1k, S1 open		20	40	ns	
t _{ZL}	CS Low to Address Output Low from Hi-Z	<i>Figures 9, 12</i> R1 = 3.5k, R2 = 1.5k		35	60	ns	
t _{LZ}	CS High to Address Output Hi-Z from Low	C _L = 15 pF, <i>Figures 9, 12</i> R1 = 1k, S2 open		25	50	ns	
tнzн	CS Low to Control Output High from Hi-Z High	<i>Figures 9, 12</i> R2 = 750Ω, S1 open		50	80	ns	
^t ннz	CS High to Control Output Hi-Z High from High	C _L = 15 pF, <i>Figures 9, 12</i> R2 = 750Ω, S1 open		40	75	ns	
^t HZL	CS Low to Control Output Low from Hi-Z High	Figure 12		45	75	ns	
t _{LHZ}	CS High to Control Output Hi-Z High from Low	$C_L = 15 \text{ pF}, Figure 12,$ R2 = 750 Ω , S1 open		50	80	ns	

Symbol	Parameter	Conditions	Min	Тур	Max	Units
CIN	Input Capacitance ADS, R/\overline{C}			8		pF
CIN	Input Capacitance All Other Inputs			5		pF
Note 2: All typica Note 3: This test parameters, a 15 Note 4: Input pul for High and 0.8° Note 5: The load Note 6: Applies	ted at these limits. The table of "Electrical Characteris' al values are for $T_A = 25^\circ$ C and $V_{CC} = 5.0$ V. is provided as a monitor of Driver output source and sir Ω resistor should be placed in series with each output u so 0V to 3.0V, $t_B = t_F = 2.5$ ns, $f = 2.5$ MHz, $t_{PW} = 20$ V for Low. d capacitance on RF I/O should not exceed 50 pF. to all DP8408A versions unless otherwise specified. 3408-2 device can only be used with memory devices to	nk current capability. Cautio Inder test. One output shou 00 ns. Input reference poin	on should be exe uld be tested at a t on AC measure	rcised in testing time and test tin	ne should not exc	eed 1 second
				TL/F/8408–15		
	FIGURE	7. Output Load Circ	uit			
Timing \	Waveform					
•						
	INPUT 3.0V ov 1.5V tHZ tHZ vol tHZ vol tLHZ	↓ • 0.5¥ •HIGH Z = 0.5¥	1.5V 1.5V	VoH Vol	L/F/8408-16	
		FIGURE 8				

If basic auto access and refresh are required, then in cases where the user requires the minimum of external complexity, Modes 0 and 5 are ideal, as shown in *Figure 9a*. The DP843X2 is used to provide proper arbitration between memory access and refresh. This chip supplies all the necessary control signals to the processor as well as the DP8408A. Furthermore, two separate \overline{CAS} outputs are also

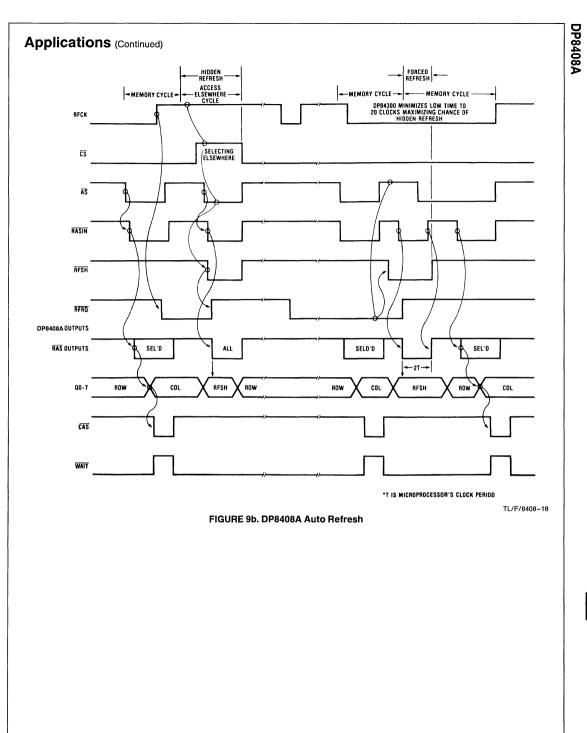
included for systems using byte-writing. The refresh clock RFCK may be divided down from either RGCK using an IC counter such as the DM74LS393 or better still, the DP84300 Programmable Refresh Timer. The DP84300 can provide RFCK periods ranging from 15.4 μ s to 15.6 μ s based on the input clock of 2 to 10 MHz. *Figure 9b* shows the general timing diagram for interfacing the DP8408A to different microprocessors using the interface controller DP843X2.

DP8408A



Applications (Continued) 16-BIT MICROPROCESSOR DATA BUS \$ RAMS MAY BE 16k OR 64k MICROPROCESSOR ADDRESS BUS RAM ADDRESS BUS DATA RO-6,7 QQ-7 A0-6,7 ADDR RAS WE CO-6,7 CASL ADDRESS DECODER B1 CAS U 80 т ТТ CS ADDR Strobe ADS . . A0-6.7 RAS CLOCK RFCK CAS L WE RAS3 DP84300 CAS U MICROPROCESSOR RAS2 RFRO DP8408A RAS 1 1 1 1 1 RASO A0-6,7 R/W WIN SELECT WAIT† RAS UPPER BYTE CAS L WF LOWER BYTE ŧ CAS U LOWER BYTE BYTE WAIT DP84XX2 114111 CAS A0-6.7 RAS RASIN WE WE † THE SELECT WAIT INPUT TO THE DP843X2 CHIP INSERTS A WAIT STATE DURING ACCESSING. THIS IS NECESSARY FOR VERY FAST MICRO-PROCESSORS RFI/O M2 M1 M0 CAS 'n ŧ ŧ "Ò 1 DM CAS U SELECT UPPER BYTE 745244 CAS L SELECT LOWER BYTE NECESSARY IF INSTRUCTIONS INCLUDE BYTE-WRITING. OTHERWISE USE CAS DIRECTLY FROM THE DP8408A TO THE RAMS.

TL/F/8408-17



National Semiconductor

DP8409A Multi-Mode Dynamic RAM Controller/Driver

General Description

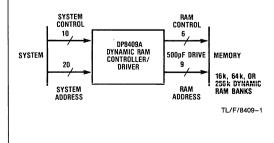
Dynamic memory system designs, which formerly required several support chips to drive the memory array, can now be implemented with a single IC ... the DP8409A Multi-Mode Dynamic RAM Controller/Driver. The DP8409A is capable of driving all 16k and 64k Dynamic RAMs (DRAMs) as well as 256k DRAMs. Since the DP8409A is a one-chip solution (including capacitive-load drivers), it minimizes propagation delay skews, the major performance disadvantage of multiple-chip memory drive and control.

The DP8409A's 8 modes of operation offer a wide selection of DRAM control capabilities. Memory access may be controlled externally or on-chip automatically; an on-chip refresh counter makes refreshing (either externally or automatically controlled) less complicated; and automatic memory initialization is both simple and fast.

The DP8409A is a 48-pin DRAM Controller/Driver with 9 multiplexed address outputs and 6 control signals. It consists of two 9-bit address latches, a 9-bit refresh counter, and control logic. All output drivers are capable of driving 500 pF loads with propagation delays of 25 ns. The DP8409A timing parameters are specified driving the typical load capacitance of 88 DRAMs, including trace capacitance.

The DP8409A has 3 mode-control pins: M2, M1, and M0, where M2 is in general REFRESH. These 3 pins select 8 modes of operation. Inputs B1 and B0 in the memory access modes (M2 = 1), are select inputs which select one of four RAS outputs. During normal access, the 9 address outputs can be selected from the Row Address Latch or the Column Address Latch. During refresh, the 9-bit on-chip refresh counter is enabled onto the address bus and in this mode all RAS outputs are selected, while CAS is inhibited.

The DP8409A can drive up to 4 banks of DRAMs, with each bank comprised of 16k's, 64k's, or 256k's. Control signal outputs RAS, CAS, and WE are provided with the same drive capability. Each RAS output drives one bank of DRAMs so that the four RAS outputs are used to select the banks, while CAS, WE, and the multiplexed addresses can be connected to all of the banks of DRAMs. This leaves the non-selected banks in the standby mode (less than one tenth of the operating power) with the data outputs in TRI-STATE®. Only the bank with its associated RAS low will be written to or read from.

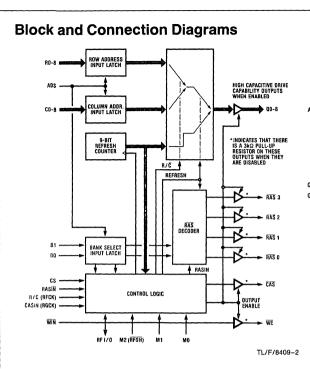


Operational Features

- All DRAM drive functions on one chip—minimizes skew on outputs, maximizes AC peformance
- On-chip capacitive-load drives (specified to drive up to 88 DRAMs)
- Drives directly all 16k, 64k, and 256k DRAMs
- Capable of addressing 64k, 256k, or 1M words
- Propagation delays of 25 ns typical at 500 pF load
- CAS goes low automatically after column addresses are valid if desired
- Auto Access mode provides RAS, row to column select, then CAS automatically and fast
- WE follows WIN unconditionally—offering READ, WRITE or READ-MODIFY-WRITE cycles
- On-chip 9-bit refresh counter with selectable End-of-Count (127, 255 or 511)
- End-of-Count indicated by RF I/O pin going low at 127, 255 or 511
- Low input on RF I/O resets 9-bit refresh counter
- CAS inhibited during refresh cycle
- Fall-through latches on address inputs controlled by ADS
- TRI-STATE outputs allow multi-controller addressing of memory
- Control output signals go high-impedance logic "1" when disabled for memory sharing
- Power-up: counter reset, control signals high, address outputs TRI-STATE, and End-of-Count set to 127

Mode Features

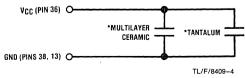
- 8 modes of operation: 3 access, 3 refresh, and 2 set-up
- 2 externally controlled modes: 1 access and 1 refresh (Modes 0, 4)
- 2 auto-access modes $\overline{RAS} \rightarrow R/\overline{C} \rightarrow \overline{CAS}$ automatic, with t_{RAH} = 20 or 30 ns minimum (Modes 5, 6)
- Auto-access mode allows Hidden Refreshing (Mode 5)
- Forced Refresh requested on RF I/O if no Hidden Refresh (Mode 5)
- Forced Refresh performed after system acknowledge of request (Mode 1)
- Automatic Burst Refresh mode stops at End-of-Count of 127, 255, or 511 (Mode 2)
- 2 All-RAS Acces modes externally or automatically controlled for memory initialization (Modes 3a, 3b)
- Automatic All-RAS mode with external 8-bit counter frees system for other set-up routines (Mode 3a)
- End-of-Count value of Refresh Counter set by B1 and B0 (Mode 7)



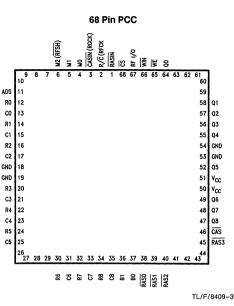
Order Number DP8409AD, DP8409AN, DP8409AN-3 or DP8409AV-2 See NS Package Number D48A, N48A or V68A

Pin Definitions

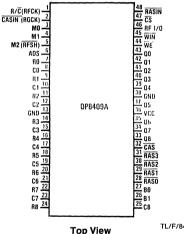
V_{CC}, GND, GND—V_{CC} = 5V \pm 5%. The three supply pins have been assigned to the center of the package to reduce voltage drops, both DC and AC. There are also two ground pins to reduce the low level noise. The second ground pin is located two pins from V_{CC}, so that decoupling capacitors can be inserted directly next to these pins. It is important to adequately decouple this device, due to the high switching currents that will occur when all 9 address bits change in the same direction simultaneously. A recommended solution would be a 1 µF multilayer ceramic capacitor in parallel with a low-voltage tantalum capacitor, both connected as close as possible to pins 36 and 38 to reduce lead inductance. See figure below.



*Capacitor values should be chosen depending on the particular application.



Dual-In-Line Package



TL/F/8409-5

R0-R8: Row Address Inputs.

C0-C8: Column Address Inputs.

Q0-Q8: Multiplexed Address Outputs-Selected from the Row Address Input Latch, the Column Address Input Latch, or the Refresh Counter.*

RASIN: Row Address Strobe Input—Enables selected RAS_n output when M2 (RFSH) is high, or all RAS_n outputs when RFSH is low.

R/C (RFCK)-In Auto-Refresh Mode this pin is the external Refresh Clock Input: one refresh cycle has to be performed each clock period. In all other modes it is Row/Column Select Input: selects either the row or column address input latch onto the output bus.

DP8409A

Pin Definitions (Continued)

Mode	(RFSH) M2	M1	мо	Mode of Operation	Conditions				
0	0	0	0	Externally Controlled Refresh	$RFI/O = \overline{EOC}$				
1	0	0	1	Auto Refresh—Forced	$RF I/O = Refresh Request (\overline{RFRQ})$				
2	0	1	0	Internal Auto Burst Refresh	$RFI/O = \overline{EOC}$				
3a	0	1	1	All RAS Auto Write	$RF I/O = \overline{EOC}; All \overline{RAS} Active$				
Зb	0	1	1	Externally Controlled All RAS Access	All RAS Active				
4	1	0	0	Externally Controlled Access	Active RAS Defined by Table II				
5	1	0	1	Auto Access, Slow t _{RAH} , Hidden Refresh	Active RAS Defined by Table II				
6	1	1	0	Auto Access, Fast t _{RAH}	Active RAS Defined by Table II				
7	1	1	1	Set End of Count	See Table III for Mode 7				

TABLE I. DP8409A Mode Select Options

CASIN (RGCK)—In Auto-Refresh Mode, Auto Burst Mode, and All-RAS Auto-Write Mode, this pin is the RAS Generator Clock input. In all other modes it is CASIN (Column Address Strobe Input), which inhibits CAS output when high in Modes 4 and 3b. In Mode 6 it can be used to prolong CAS output.

ADS: Address (Latch) Strobe Input—Row Address, Column Address, and Bank Select Latches are fall-through with ADS high; Latches on high-to-low transition.

CS: Chip Select Input—The TRI-STATE mode will Address Outputs and puts the control signal into a high-impedance logic "1" state when high (unless refreshing in one of the Refresh Modes). Enables all outputs when low.

M0, M1, M2: Mode Control Inputs—These 3 control pins determine the 8 major modes of operation of the DP8409A as depicted in Table I.

RF I/O—The I/O pin functions as a Reset Counter Input when set low from an external open-collector gate, or as a flag output. The flag goes active-low in Modes 0 and 2 when the End-of-Count output is at 127, 255, or 511 (see Table III). In Auto-Refresh Mode it is the Refresh Request output.

WIN: Write Enable Input.

WE: Write Enable Output-Buffered output from WIN.*

CAS: Column Address Strobe Output—In Modes 3a, 5, and 6, CAS transitions low following valid column address. In Modes 3b and 4, it goes low after R/\overline{C} goes low, or follows CASIN going low if R/\overline{C} is already low. CAS is high duing refresh.*

RAS 0-3: Row Address Strobe Outputs—Selects a memory bank decoded from B1 and B0 (see Table II), if RFSH is high. If RFSH is low, all banks are selected.*

B0, B1: Bank Select Inputs—Strobed by ADS. Decoded to enable one of the RAS outputs when RASIN goes low. Also used to define End-of-Count in Mode 7 (Table III).

Conditions for All Modes

INPUT ADDRESSING

The address block consists of a row-address latch, a column-address latch, and a resettable refresh counter. The address latches are fall-through when ADS is high and latch when ADS goes low. If the address bus contains valid addresses until after the valid address time, ADS can be permanently high. Otherwise ADS must go low while the addresses are still valid.

In normal memory access operation, $\overrightarrow{\text{RASIN}}$ and $\overrightarrow{\text{R/C}}$ are initially high. When the address inputs are enabled into the address latches, the row addresses appear on the Q outputs. The address strobe also inputs the bank-select address, (B0 and B1). If $\overrightarrow{\text{CS}}$ is low, all outputs are enabled. When $\overrightarrow{\text{CS}}$ is transitioned high, the address outputs go TRI-STATE and the control outputs first go high through a low impedance, and then are held by an on-chip high impedance. This allows output paralleling with other DP8409As for multi-addressing. All outputs go active about 50 ns after the chip is selected again. If $\overrightarrow{\text{CS}}$ is high, and a refresh cycle begins, all the outputs become active until the end of the refresh cycle.

DRIVE CAPABILITY

The DP8409A has timing parameters that are specified with up to 600 pF loads. In a typical memory system this is equivalent to about 88, 5V-only DRAMs, with trace lengths kept to a minimum. Therefore, the chip can drive four banks each of 16 or 22 bits, or two banks of 32 or 39 bits, or one bank of 64 or 72 bits.

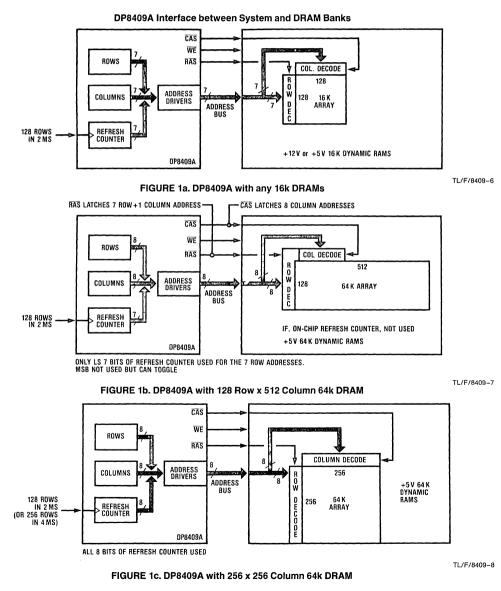
Less loading will slightly reduce the timing parameters, and more loading will increase the timing parameters, according to the graph of *Figure 10*. The AC performance parameters are specified with the typical load capacitance of 88 DRAMs. This graph can be used to extrapolate the variations expected with other loading.

Because of distributed trace capacitance and inductance and DRAM input capacitance, current spikes can be created, causing overshoots and undershoots at the DRAM inputs that can change the contents of the DRAMs or even destroy them. To remove these spikes, a damping resistor (low inductance, carbon) can be inserted between the DP8409A driver outputs and the DRAMs, as close as possible to the DP8409A. The values of the damping resistors may differ between the different control outputs; RASs, CAS, Q's, and WE. The damping resistors should be determined by the first prototypes (not wire-wrapped due to the larger distributed capacitance and inductance). The best values for the damping resistors are the critical values giving a critically damped transition on the control outputs. Typical values for the damping resistors will be between 15Ω and 100 Ω , the lower the loading the higher the value. (For more information, see AN-305 "Precautions to Take When Driving Memories.")

The DP8409A can drive any 16k or 64k DRAMs. All 16k DRAMs are basically the same configuration, including the newer 5V-only version. Hence, in most applications, different manufacturers' DRAMs are interchangeable (for the same supply-rail chips), and the DP8409A can drive all 16k DRAMs (see *Figure 1a*).

There are three basic configurations for the 5V-only 64k DRAMs: a 128-row by 512-column array with an on-RAM refresh counter, a 128-row by 512-column array with no on-RAM refresh counter, and a 256-row by 256-column array

with no on-RAM refresh counter. The DP8409A can drive all three configurations, and at the same time allows them all to be interchangeable (as shown in *Figures 1b* and *1c*), providing maximum flexibility in the choice of DRAMs. Since the 9-bit on-chip refresh counter can be used as a 7-bit refresh counter for the 128-row configuration, or as an 8-bit refresh counter for the 256-row configuration, the on-RAM refresh counter (if present) is never used. As long as 128 rows are refreshed every 2 ms (i.e. 256 rows in 4 ms) all DRAM types are correctly refreshed.



Conditions for All Modes (Continued)

When the DP8409A is in a refresh mode, the RF.I/O pin indicates that the on-chip refresh counter has reached its end-of-count. This end-of-count is selectable as 127, 255 or 512 to accommodate 16k, 64k or 256k DRAMs. Although the end-of-count may be chosen to be any of these, the counter always counts to 511 before rolling over to zero.

READ, WRITE, AND READ-MODIFY-WRITE CYCLES

The output signal, \overline{WE} , determines what type of memory access cycle the memory will perform. If \overline{WE} is kept high while \overline{CAS} goes low, a read cycle occurs. If \overline{WE} goes low before \overline{CAS} goes low, a write cycle occurs and data at DI (DRAM input data) is written into the DRAM as \overline{CAS} goes low later than t_{CWD} after \overline{CAS} goes low, first a read occurs and DO (DRAM output data) becomes valid; then data DI is written into the same address in the DRAM when \overline{WE} goes low. In this read-modify-write case, DI and DO connot be linked together. The type of cycle is therefore controlled by \overline{WE} , which follows \overline{WIN} .

POWER-UP INITIALIZE

When V_{CC} is first applied to the DP8409A, an initialize pulse clears the refresh counter, the internal control flip-flops, and set the End-of-Count of the refresh counter to 127 (which may be changed via Mode 7). As V_{CC} increases to about 2.3V, it holds the output control signals at a level of one Schottky diode-drop below V_{CC}, and the output address to TRI-STATE. As V_{CC} increases above 2.3V, control of these outputs is granted to the system.

DP8409A Functional Mode Descriptions

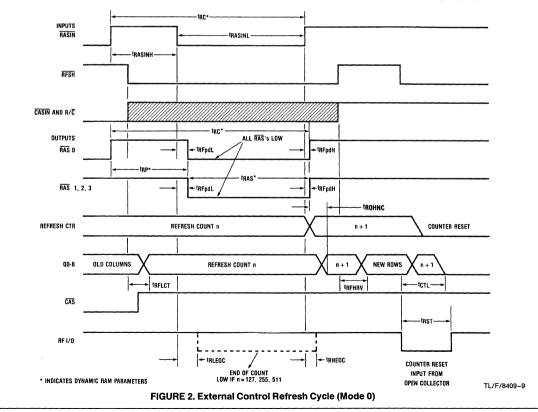
Note: All delay parameters stated in text refer to the DP8409A. Substitute the respective delay numbers for the DP8409-2 or DP8409-3 when using these devices.

MODE 0-EXTERNALLY CONTROLLED REFRESH

Figure 2 is the Externally Controlled Refresh Timing. In this mode, the input address latches are disabled from the address outputs and the refresh counter is enabled. When RAS occurs, the enabled row in the DRAM is refreshed. In the Externally Controlled Refresh mode, all RAS outputs are enabled following RASIN, and CAS is inhibited. This refreshes the same row in all four banks. The refresh counter increments when either RASIN or RESH goes low-to-high after a refresh. RF I/O goes low when the count is 127, 255, or 511, as set by End-of-Count (see Table III), with RASIN and RESH low. To reset the counter to all zeros, RF I/O is set low through an external open-collector driver.

During refresh, $\overrightarrow{\text{RASIN}}$ and RFSH must be skewed transitioning low such that the refresh address is valid on the address outputs of the controller before the $\overrightarrow{\text{RAS}}$ outputs go low. The amount of time that RFSH should go low before $\overrightarrow{\text{RASIN}}$ does depends on the capacitive loading of the address and $\overrightarrow{\text{RAS}}$ lines. For the load specified in the switching characteristics of this data sheet, 10 ns is sufficient. Refer to *Figure 2.*

To perform externally controlled burst refresh, RASIN is toggled while RFSH is held low. The refresh counter increments with RASIN going low to high, so that the DRAM rows are refreshed in succession by RASIN going high to low.



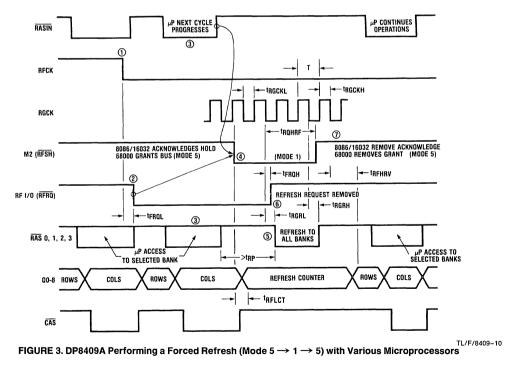
DP8409A Functional Mode Descriptions (Continued) MODE 1—AUTOMATIC FORCED REFRESH DBAMS, AR

In Mode 1, the R/\overline{C} (RFCK) pin becomes RFCK (refresh cycle clock), instead of R/\overline{C} , and \overline{CAS} remains high. If RFCK is kept permanently high, then whenever M2 (RFSH) goes low, an externally controlled refresh will occur and all RAS outputs will follow RASIN, strobing the refresh counter contents to the DRAMs. The RF I/O pin will always output high, but when set low externally through an open-collector driver, the refresh counter resets as normal. This externally controlled method may be preferred when operating in the Automatic Access mode (Mode 5), where hidden or forced refreshing is undesirable, but refreshing is still necessary.

If RFCK is an input clock signal, one (and only one) refresh cycle must take place every RFCK cycle. Refer to *Figure 9*. If a hidden refresh does not occur while RFCK is high, in Mode 5, then RF I/O (Refresh Request) goes low immediately after RFCK goes low, indicating to the system that a forced refresh to take place while RFCK is low (refer to *Figure 3*). The Refresh Request signal on RF I/O may be connected to a Hold or Bus Request input to the system. The system acknowledges the Hold or Bus Request Acknowledge. If this is connected to the M2 (RFSH) pin, a forced-refresh cycle will be initiated by the DP8409A, and RAS will be internally generated on all four RAS outputs, to strobe the refresh counter contents on the address outputs into all the

DRAMs. An external RAS Generator Clock (RGCK) is required for this function. It is fed to the CASIN (RGCK) pin, and may be up to 10 MHz. Whenever M2 goes low (inducing a forced refresh), RAS remains high for one to two periods of RGCK, depending on when M2 goes low relative to the high-to-low triggering edge of RGCK; RAS then goes low for two periods, performing a refresh on all banks. In order to obtain the minimum delay from M2 going low to RAS going low, M2 should go low t_{RFSRG} before the next falling edge of RGCK. The Refresh Request on RF I/O is terminated as RAS begins, so that by the time the system has acknowledged the removal of the request and disabled its Acknowledge, (i.e., M2 goes high), Refresh RAS will have ended, and normal operations can begin again in the Automatic Access mode (Mode 5). If it is desired that Refresh RAS end in less than 2 periods of RGCK from the time RAS went low. then M2 may be high earlier than t_{RQHRF} after RGCK goes low and RAS will go high t_{RFRH} after M2, if CS is low. If CS is high, the RAS will go high after 25 ns after M2 goes high.

To allow the forced refresh, the system will have been inactive for about 4 periods of RGCK, which can be as fast as 400 ns every RFCK cycle. To guarantee a refresh of 128 rows every 2 ms, a period of up to 16 μ s is required for RFCK. In other words, the system may be down for as little as 400 ns every 16 μ s, or 2.5% of the time. Although this is not excessive, it may be preferable to perform a Hidden Refresh each RFCK cycle, which is allowed while still in the Auto-Access mode, (Mode 5).



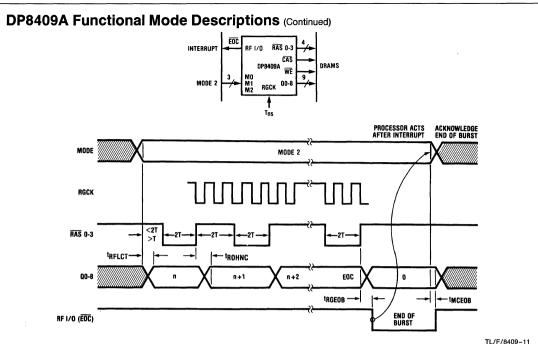


FIGURE 4. Auto-Burst Mode, Mode 2

MODE 2—AUTOMATIC BURST REFRESH

This mode is normally used before and/or after a DMA operation to ensure that all rows remain refreshed, provided the DMA transfer takes less than 2 ms (see Figure 4). When the DP8409A enters this mode, CASIN (RGCK) becomes the RAS Generator Clock (RGCK), and RASIN is disabled. CAS remains high, and RF I/O goes low when the refresh counter has reached the selected End-of-Count and the last RAS has ended. RF I/O then remains low until the Auto-Burst Refresh mode is terminated. RF I/O can therefore be used as an interrupt to indicate the End-of-Burst conditions.

The signal on all four RAS outputs is just a divide-by-four of RGCK; in other words, if RGCK has a 100 ns period, RAS is high and low for 200 ns each cycle. The refresh counter increments at the end of each RAS, starting from the count it contained when the mode was entered. If this was zero, then for a RGCK with a 100 ns period with End-of-Count set to 127, RF I/O will go low after 128 \times 0.4 μ s, or 51.2 μ s. During this time, the system may be performing operations that do not involve DRAM. If all rows need to be burst refreshed, the refresh counter may be cleared by setting RF I/O low externally before the burst begins.

Burst-mode refreshing is also useful when powering down systems for long periods of time, but with data retention still required while the DRAMs are in standby. To maintain valid refreshing, power can be applied to the DP8409A (set to Mode 2), causing it to perform a complete burst refresh. When end-of-burst occurs (after 26 µs), power can then be removed from the DP8409A for 2 ms, consuming an average power of 1.3% of normal operating power. No control signal glitches occur when switching power to the DP8409A.

MODE 3a-ALL-RAS AUTOMATIC WRITE

Mode 3a is useful at system initialization, when the memory is being cleared (i.e., with all-zeros in the data field and the corresponding check bits for error detection and correction). This requires writing the same data to each location of memory (every row of each column of each bank). All RAS outputs are activated, as in refresh, and so are CAS and WE. To write to all four banks simultaneously, every row is strobed in each column, in sequence, until data has been written to all locations.

To select this mode, B1 and B0 must have previously been set to 00, 01, or 10 in Mode 7, depending on the DRAM size. For example, for 16k DRAMs, B1 and B0 are 00. For 64k DRAMs, B1 and B0 are 01, so that for the configuration of Figure 1b, the 8 refresh counter bits are strobed by RAS into the 7 row addresses and the ninth column address. After this Automatic-Write process, B1 and B0 must be set again in Mode 7 to 00 to set End-of-Count to 127. For the configuration of Figure 1c, B1 and B0 set to 01 will work for Automatic-Write and End-of-Count equals 255.

In this mode, R/\overline{C} is disabled, \overline{WE} is permanently enabled low, and CASIN (RGCK) becomes RGCK. RF I/O goes low whenever the refresh counter is 127, 255, or 511 (as set by End-of-Count in Mode 7), and the RAS outputs are active.

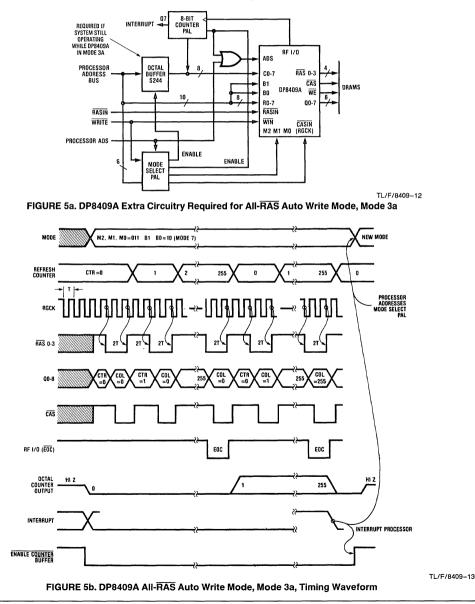
Referring to Figure 5a, an external 8-bit counter (for 64k DRAMs) with TRI-STATE outputs is required and must be connected to the column address inputs. It is enabled only during this mode, and is clocked from RF I/O. The DP8409A refresh counter is used to address the rows, and the column address is supplied by the external counter. Everv row for each column address is written to in all four banks. At the End-of-Count RF I/O goes low, which clocks the external counter.

Therefore, for each column address, the refresh counter first outputs row-0 to the address bus and all four RAS outputs strobe this row address into the DRAMs (see Figure 5b). A minimum of 30 ns after RAS goes low (tRAH = 30 ns), the refresh counter is disabled and the column ad-

DP8409A Functional Mode Descriptions (Continued)

dress input latch is enabled onto the address bus. About 14 ns after the column address is valid, \overline{CAS} goes low, ($t_{ASC} = +14$ ns), strobing the column address into the DRAMs. When RAS and \overline{CAS} go high the refresh counter increments to the next row and the cycle repeats. Since \overline{WE} is kept low in this mode, the data at DI (input data) of the DRAMs is written into each row of the latched column. During each cycle RAS is high for two periods of RGCK and low for two periods, giving a total write-cycle time of 400 ns minimum, which is adequate for most 16k and 64k DRAMs. On the last row of a column, RF I/O increments the external counter to the next column address.

At the end of the last column address, an interrupt is generated from the external counter to let the system know that initialization has been completed. During the entire initialization time, the system can be performing other initialization functions. This approach to memory initialization is both automatic and fast. For instance, if four banks of 64k DRAMs are used, and RGCK is 100 ns, a write cycle to the same location in all four banks takes 400 ns, so the total time taken in initializing the 64k DRAMs is $65k \times 400$ ns or 26 ms. When the system receives the interrupt, the external counter must be permanently disabled. ADS and \overline{CS} are interfaced by the system, and the DP8409A mode is changed. The interrupt must then be disabled.



DP8409A Functional Mode Descriptions (Continued)

MODE 3b—EXTERNALLY CONTROLLED ALL-RAS WRITE

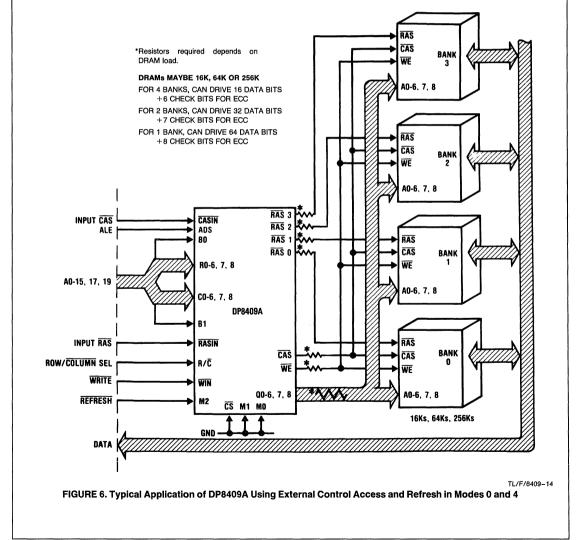
To select this mode. B1 and B0 must first have been set to 11 in Mode 7. This mode is useful at system initialization, but under processor control. The memory address is provided by the processor, which also performs the incrementing. All four RAS outputs follow RASIN (supplied by the processor), strobing the row address into the DRAMs. R/C can now go low, while CASIN may be used to control CAS (as in the Externally Controlled Access mode), so that CAS strobes the column address contents into the DRAMs. At this time WE should be low, causing the data to be written into all four banks of DRAMs. At the end of the write cycle, the input address is incremented and latched by the DP8409A for the next write cycle. This method is slower than Mode 3a since the processor must perform the incrementing and accessing. Thus the processor is occupied during RAM initialization, and is not free for other initialization operations. However, initialization sequence timing is under system control, which may provide some system advantage.

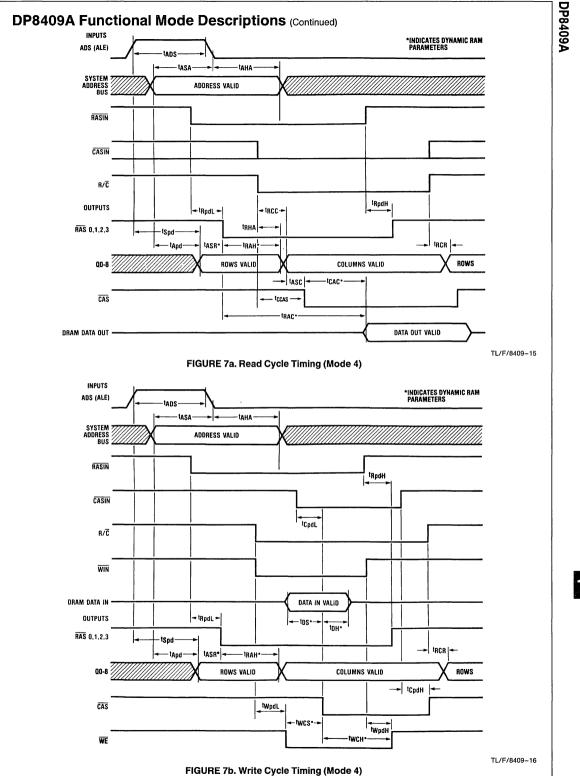
MODE 4—EXTERNALLY CONTROLLED ACCESS

This mode facilitates externally controlling all access-timing parameters associated with the DRAMs. The application of modes 0 and 4 are shown in *Figure 6*.

Output Address Selection

Refer to *Figure 7a.* With M2 (RFSH) and R/C high, the row address latch contents are transferred to the multiplexed address bus output Q0–Q8, provided \overline{CS} is set low. The column address latch contents are output after R/C goes low. RASIN can go low after the row addresses have been set up on Q0–Q8. This selects one of the RAS outputs, strobing the row address on the Q outputs into the desired bank of memory. After the row-address hold-time of the DRAMs, R/C can go low so that about 40 ns later column addresses appear on the Q outputs.





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DP8409A Functional Mode Descriptions (Continued)

Automatic CAS Generation

In a normal memory access cycle \overline{CAS} can be derived from inputs \overline{CASIN} or R/\overline{C} . If \overline{CASIN} is high, then R/C going low switches the address output drivers from rows to columns. \overline{CASIN} then going low causes \overline{CAS} to go low approximately 40 ns later, allowing \overline{CAS} to occur at a predictable time (see *Figure 7b*). If \overline{CASIN} is low when R/\overline{C} goes low, \overline{CAS} will be automatically generated, following the row to column transition by about 20 ns (see *Figure 7a*). Most DRAMs have a column address set-up time before \overline{CAS} (t_{ASC}) of 0 ns or -10 ns. In other words, a t_{ASC} greater than 0 ns is safe.

Fast Memory Access

AC parameters t_{DIF1} , t_{DIF2} may be used to determine the minimum delays required between \overline{RASIN} , R/\overline{C} , and \overline{CASIN} (see Application Brief 9; "Fastest DRAM Access Mode").

MODE 5-AUTOMATIC ACCESS WITH HIDDEN REFRESH

The Auto Access with Hidden Refresh mode has two advantages over the Externally Controlled Access mode, due to the fact that all outputs except \overline{WE} are initiated from RASIN. First, inputs R/C and CASIN are unnecessary and can be used for other functions (see Refreshing, below). Secondly, because the output control signals are derived internally from one input signal (RASIN), timing-skew problems are reduced, thereby reducing memory access time substantially or allowing use of slower DRAMs. The automatic access features of Mode 5 (and Mode 6) of the DP8409A make DRAM accessing appear essentially "static".

Automatic Access Control

The major disadvantage of DRAMs compared to static RAMs is the complex timing involved. First, a $\overline{\text{RAS}}$ must occur with the row address previously set up on the multiplexed address bus. After the row address has been held for t_{RAH}, (the Row-Address hold-time of the DRAM), the column address is set up and then $\overline{\text{CAS}}$ occurs. This is all performed automatically by the DP8409A in this mode.

Provided the input address is valid as ADS goes low, \overrightarrow{RASIN} can go low any time after ADS. This is because the selected \overrightarrow{RAS} occurs typically 27 ns later, by which time the row address is already valid on the address output of the DP8409A. The Address Set-Up time (t_{ASR}), is 0 ns on most DRAMs. The DP8409A in this mode (with ADS and \overrightarrow{RASIN} edges simultaneously applied) produces a minimum t_{ASR} of 0 ns. This is true provided the input address was valid t_{ASA} before ADS went low (see *Figure 8a*).

Next, the row address is disabled after t_{RAH} (30 ns minimum); in most DRAMs, t_{RAH} minimum is less than 30 ns. The column address is then set up and t_{ASC} later, \overline{CAS} occurs. The only other control input required is \overline{WIN} . When a write cycle is required, \overline{WIN} must go low at least 30 ns before \overline{CAS} is output low.

This gives a total typical delay from: input address valid to RASIN (15 ns); to RAS (27 ns); to rows held (50 ns); to columns valid (25 ns); to \overline{CAS} (23 ns) = 140 ns (that is, 125 ns from RASIN). All of these typcial figures are for heavy capacitive loading, of approximately 88 DRAMs.

This mode is therefore extremely fast. The external timing is greatly simplified for the memory system designer: the only system signal required is **RASIN**.

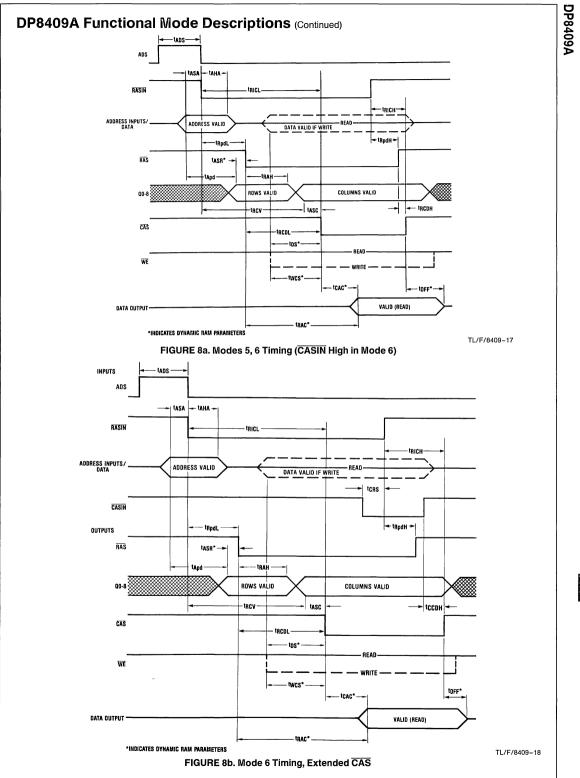
Refreshing

Because R/ \overline{C} and \overline{CASIN} are not used in this mode, R/ \overline{C} becomes RFCK (refresh clock) and \overline{CASIN} becomes RGCK (RAS generator clock). With these two signals it is possible to peform refreshing without extra ICs, and without holding up the processor.

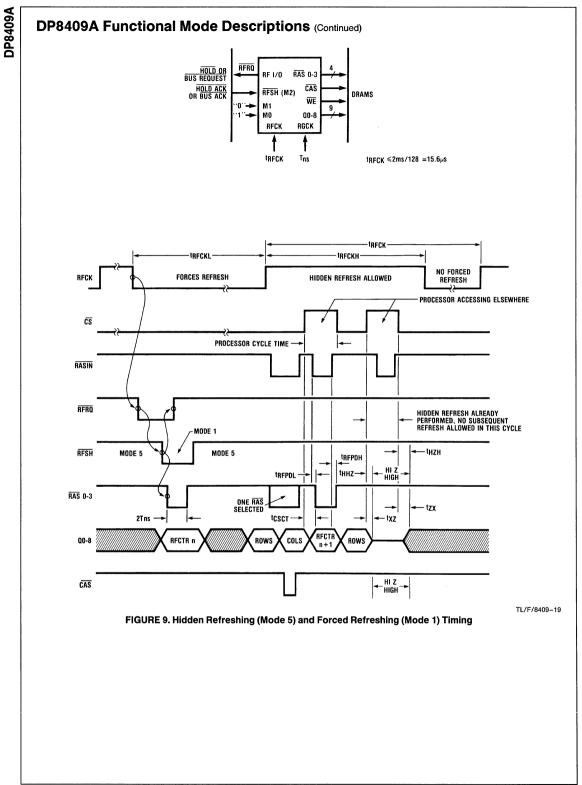
One refresh cycle must occur during each refresh clock period and then the refresh address must be incremented to the next refresh cycle. As long as 128 rows are refreshed every 2 ms (one row every 16 us), all 16k and 64k DRAMs will be correctly refreshed. The cycle time of RFCK must, therefore, be less than 16 us. RFCK going high sets an internal refresh-request flip-flop. First the DP8409A will attempt to perform a hidden refresh so that the system throughput will not be affected. If, during the time RFCK is high, CS on the DP8409A goes high and RASIN occurs, a hidden refresh will occur. In this case, RASIN should be considered a common read/write strobe. In other words, if the processor is accessing elsewhere (other than the DRAMs) while RFCK is high, the DP8409A will perform a refresh. The refresh counter is enabled to the address outputs whenever CS goes high with RFCK high, and all RAS outputs follow RASIN. If a hidden refresh is taking place as RFCK goes low, the refresh continues. At the start of the hidden refresh, the refresh-request flip-flop is reset so no further refresh can occur until the next RFCK period starts with the positive-going edge of RFCK. Refer to Figure 9.

To determine the probability of a Hidden Refresh occurring, assume each system cycle takes 400 ns and RFCK is high for 8 μ s, then the system has 20 chances to not select the DP8409A. If during this time a hidden refresh did not occur, then the DP8409A forces a refresh while RFCK is low, but the system chooses when the refresh takes place. After RFCK goes low, (and the internal-request flip-flop has not been reset), RF I/O goes low indicating that a refresh is requested to the system. Only when the system acknowledges this request by setting M2 (RFSH) low does the DP8409A initiate a forced refresh (which is performed automatically). Refer to Mode 1, and *Figure 3*. The internal refresh request flip-flop is then reset.

Figure 9 illustrates the refresh alternatives in Mode 5. If a hidden refresh has occurred and \overline{CS} again goes high before RFCK goes low, the chip is deselected. All the control signals go high-impedance high (logic "1") and the address outputs go TRI-STATE until \overline{CS} again goes low. This mode (combined with Mode 1) allows very fast access, and automatic refreshing (possibly not even slowing down the system), with no extra ICs. Careful system design can, and should, provide a higher probability of hidden refresh occurring. The duty cycle of RFCK need not be 50-percent; in fact, the low-time should be designed to be a minimum. This is determined by the worst-case time (required by the system) to respond to the DP8409A's forced-refresh request.



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DP8409A Functional Mode Descriptions (Continued)

TABLE II. Memory Bank Decode

	Select by ADS)	Enabled RAS _n
B1	B0	
0	0	RAS ₀
0	1	RAS ₁
1	0	RAS ₂
1	1	RAS ₃

Note that $\overline{\text{RASIN}}$ going low earlier than t_{CSRL} after $\overline{\text{CS}}$ goes low may result in the DP8409A interpreting the $\overline{\text{RASIN}}$ as a hidden refresh $\overline{\text{RASIN}}$ if no hidden refresh has occurred in the current RFCK cycle. In this case, all $\overline{\text{RAS}}$ outputs would go low for a short time. Thus, it is suggested that when using Mode 5, $\overline{\text{RASIN}}$ should be held high until $t_{\underline{\text{CSRL}}}$ after $\overline{\text{CS}}$ goes low if a refresh is not intended. Similarly, $\overline{\text{CS}}$ should be held low for a minimum of $t_{\underline{\text{CSRL}}}$ after $\overline{\text{RASIN}}$ returns high when ending the access in Mode 5.

MODE 6-FAST AUTOMATIC ACCESS

The Fast Access mode is similar to Mode 5, but has a faster $t_{\rm RAH}$ of 20 ns, minimum. It therefore can only be used with fast 16k or 64k DRAMs (which have a $t_{\rm RAH}$ of 10 ns to 15 ns) in applications requiring fast access times; $\rm \overline{RASIN}$ to $\rm \overline{CAS}$ is typically 105 ns.

In this mode, the R/\overline{C} (RFCK) pin is not used, but \overline{CASIN} (RGCK) is used as \overline{CASIN} to allow an extended \overline{CAS} after \overline{RAS} has already terminated. Refer to *Figure 8b*. This is de-

sirable with fast cycle-times where $\overline{\text{RAS}}$ has to be terminated as soon as possible before the next $\overline{\text{RAS}}$ begins (to meet the precharge time, or t_{RP} , requirements of the DRAM). $\overline{\text{CAS}}$ may then be held low by $\overline{\text{CASIN}}$ to extend the data output valid time from the DRAM to allow the system to read the data. $\overline{\text{CASIN}}$ subsequently going high ends $\overline{\text{CAS}}$. If this extended $\overline{\text{CAS}}$ is not required, $\overline{\text{CASIN}}$ should be set high in Mode 6.

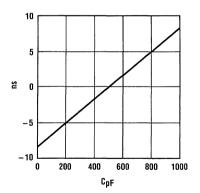
There is no internal refresh-request flip-flop in this mode, so any refreshing required must be done by entering Mode 0 or Mode 2.

MODE 7-SET END-OF-COUNT

The End-of-Count can be externally selected in Mode 7, using ADS to strobe in the respective value of B1 and B0 (see Table III). With B1 and B0 the same $\overline{\text{EOC}}$ is 127; with B1 = 0 and B0 = 1, $\overline{\text{EOC}}$ is 255; and with B1 = 1 and B0 = 0, $\overline{\text{EOC}}$ is 511. This selected value of $\overline{\text{EOC}}$ will be used until the next Mode 7 selection. At power-up the $\overline{\text{EOC}}$ is automatically set to 127 (B1 and B0 set to 11).

T/	٩B	LE	111.	Mode	7
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	Select d by ADS)	End of Count Selected
B1	BO	Selected
0	0	127
0	1	255
1	0	511
1	1	127



TL/F/8409-20

FIGURE 10. Change in Propagation Delay vs. Loading Capacitance Relative to a 500 pF Load

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage, V _{CC}	7.0V
Storage Temperature Range -	65°C to +150°C
Input Voltage	5.5V
Output Current	150 mA
Lead Temperature (Soldering, 10 seconds)	300°C

Maximum Power Dissipation* at 25°CCavity Package3542 mWMolded Package2833 mW

*Derate cavity package 23.6 mW/°C above 25°C; derate molded package 22.7 mW/°C above 25°C.

Operating Conditions

	Min	Max	Units
V _{CC} Supply Voltage	4.75	5.25	ν
T _A Ambient Temperature	0	+70	°C

Electrical Characteristics $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 6)

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _C	Input Clamp Voltage	$V_{CC} = Min, I_C = -12 mA$		-0.8	-1.2	V
liH1	Input High Current for ADS, R/C Only	V _{IN} = 2.5V		2.0	100	μΑ
I _{IH2}	Input High Current for All Other Inputs*	V _{IN} = 2.5V		1.0	50	μΑ
I _I RSI	Output Load Current for RF I/O	V _{IN} = 0.5V, Output High		-1.5	-2.5	mA
II CTL	Output Load Current for RAS, CAS, WE	V _{IN} = 0.5V, Chip Deselect		-1.5	-2.5	mA
l _{IL1}	Input Low Current for ADS, R/C Only	$V_{IN} = 0.5V$		-0.1	-1.0	mA
IIL2	Input Low Current for All Other Inputs*	$V_{IN} = 0.5V$		-0.05	-0.5	mA
VIL	Input Low Threshold				0.8	v
VIH	Input High Threshold		2.0			V
V _{OL1}	Output Low Voltage*	$I_{OL} = 20 \text{ mA}$		0.3	0.5	v
V _{OL2}	Output Low Voltage for RF I/O	$I_{OL} = 10 \text{ mA}$		0.3	0.5	V
V _{OH1}	Output High Voltage*	I _{OH} = −1 mA	2.4	3.5		v
V _{OH2}	Output High Voltage for RF I/O	I _{OH} = − 100 μA	2.4	3.5		V
I _{1D}	Output High Drive Current*	V _{OUT} = 0.8V (Note 3)		-200		mA
I _{OD}	Output Low Drive Current*	V _{OUT} = 2.7V (Note 3)		200		mA
l _{oz}	TRI-STATE Output Current (Address Outputs)	$\begin{array}{l} 0.4 V \leq V_{OUT} \leq 2.7V, \\ \overline{\mathrm{CS}} = 2.0V, Mode \; 4 \end{array}$	-50	1.0	50	μΑ
Icc	Supply Current	V _{CC} = Max		250	325	mA

*Except RF I/O Output.

Switching Characteristics: DP8409A/DP8409A-3

 $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs including trace capacitance. These values are: Q0–Q8, C_L = 500 pF; RAS0–RAS3, C_L = 150 pF; WE, C_L = 500 pF; CAS, C_L = 600 pF, (unless otherwise noted). See *Figure 11* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k Ω unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Conditions		8409		8409A-3			Units
Symbol	Falameter	Conditions	Min	Тур	Max	Min	Тур	Max	Units
ACCESS									
t _{RICL}	RASIN to CAS Output Delay (Mode 5)	Figure 8a	95	125	160	95	125	185	ns
t _{RICL}	RASIN to CAS Output Delay (Mode 6)	Figures 8a, 8b	80	105	140	80	105	160	ns
t _{RICH}	$\overline{\text{RASIN}}$ to $\overline{\text{CAS}}$ Output Delay (Mode 5)	Figure 8a	40	48	60	40	48	70	ns
t _{RICH}	RASIN to CAS Output Delay (Mode 6)	Figures 8a, 8b	50	63	80	50	63	95	ns
t _{RCDL}	\overline{RAS} to \overline{CAS} Output Delay (Mode 5)	Figure 8a		98	125		98	145	ns
t _{RCDL}	RAS to CAS Output Delay (Mode 6)	Figures 8a, 8b		78	105		78	120	ns
^t RCDH	RAS to CAS Output Delay (Mode 5)	Figure 8a		27	40		27	40	ns
t _{RCDH}	RAS to CAS Output Delay (Mode 6)	Figure 8a		40	65		40	65	ns

Switching Characteristics: DP8409A/DP8409A-3 (Continued) $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs including trace capacitance. These values are: Q0–Q8, $C_L = 500$ pF; RAS0–RAS3, $C_L = 150$ pF; WE, $C_L = 500$ pF; CAS, $C_L = 600$ pF, (unless otherwise noted). See *Figure 11* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 kΩ unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Conditions		P8409	A	A DP8409A-3			
			Min	Тур	Max	Min	Тур	Max	Unit
ACCESS (Continued)								
t _{CCDH}	CASIN to CAS Output Delay (Mode 6)	Figure 8b	40	54	70	40	54	80	ns
t _{RAH}	Row Address Hold Time (Mode 5)	Figure 8a	30			30			ns
t _{RAH}	Row Address Hold Time (Mode 6)	Figures 8a, 8b	20			20			ns
t _{ASC}	Column Address Setup Time (Mode 5)	Figure 8a	8			8			ns
tASC	Column Address Setup Time (Mode 6)	Figures 8a, 8b	6			6			ns
t _{RCV}	RASIN to Column Address Valid (Mode 5)	Figure 8a		90	120		90	140	ns
t _{RCV}	RASIN to Column Address Valid (Mode 6)	Figures 8a, 8b		75	105		75	120	ns
t _{RPDL}	RASIN to RAS Delay	Figures 7a, 7b, 8a, 8b	20	27	35	20	27	40	ns
t _{RPDH}	RASIN to RAS Delay	Figures 7a, 7b, 8a, 8b	15	23	32	15	23	37	ns
tAPDL	Address Input to Output Low Delay	Figures 7a, 7b, 8a, 8b		25	40		25	46	ns
t _{APDH}	Address Input to Output High Delay	Figures 7a, 7b, 8a, 8b		25	40		25	46	ns
tSPDL	Address Strobe to Address Output Low	Figures 7a, 7b		40	60		40	70	ns
t _{SPDH}	Address Strobe to Address Output High	Figures 7a, 7b		40	60		40	70	ns
t _{ASA}	Address Set-Up Time to ADS	Figures 7a, 7b, 8a, 8b	15			15			ns
t _{AHA}	Address Hold Time from ADS	Figures 7a, 7b, 8a, 8b	15			15			ns
t _{ADS}	Address Strobe Pulse Width	Figures 7a, 7b, 8a, 8b	30			30			ns
t _{WPDL}	WIN to WE Output Delay	Figure 7b	15	25	30	15	25	35	ns
tWPDH	WIN to WE Output Delay	Figure 7b	15	30	60	15	30	70	ns
tCRS	CASIN Set-Up Time to RASIN High (Mode 6)	Figure 8b	35			35			ns
t _{CPDL}	CASIN to CAS Delay (R/C Low in Mode 4)	Figure 7b	32	41	68	32	41	77	ns
t _{CPDH}	$\overline{\text{CASIN}}$ to $\overline{\text{CAS}}$ Delay (R/ $\overline{\text{C}}$ Low in Mode 4)	Figure 7b	25	39	50	25	39	60	ns
tRCC	Column Select to Column Address Valid	Figure 7a		40	58		40	67	ns
t _{RCR}	Row Select to Row Address Valid	Figures 7a, 7b		40	58		40	67	ns
t _{RHA}	Row Address Held from Column Select	Figure 7a	10			10			ns
tCCAS	R/\overline{C} Low to \overline{CAS} Low (Mode 4 Auto \overline{CAS})	Figure 7a		65	90				ns
t _{DIF1}	Maximum (t _{RPDL} - t _{RHA})	See Mode 4 Descrip.			13			18	ns
t _{DIF2}	Maximum (t _{RCC} - t _{CPDL})	See Mode 4 Descrip.			13			18	ns
REFRESH									
t _{RC}	Refresh Cycle Period	Figure 2	100			100			ns
^t RASINL, H	Pulse Width of RASIN during Refresh	Figure 2	50			50			ns
t _{RFPDL}	RASIN to RAS Delay during Refresh	Figures 2, 9	35	50	70	35	50	80	ns
t _{RFPDH}	RASIN to RAS Delay during Refresh	Figures 2, 9	30	40	55	30	40	65	ns
t _{RFLCT}	RFSH Low to Counter Address Valid	$\overline{\text{CS}} = X$, Figures 2, 3, 4		47	60		47	70	ns

Switching Characteristics: DP8409A/DP8409A-3 (Continued) $V_{CC} = 5.0V \pm 5\%$, $0^{\circ}C \leq T_A \leq 70^{\circ}C$ (unless otherwise noted) (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs including trace capacitance. These values are: Q0–Q8, $C_L = 500$ pF; $\overline{RAS0}$ - $\overline{RAS3}$, $C_L = 150$ pF; \overline{WE} , $C_L = 500$ pF; \overline{CAS} , $C_L = 600$ pF, (unless otherwise noted). See *Figure 11* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k Ω unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Conditions		DP8409A			DP8409A-3		
Symbol	Falancici	Conditions	Min	Тур	Max	Min	Тур	Max	Unite
REFRESH	I (Continued)								
t _{RFHRV}	RFSH High to Row Address Valid	Figures 2, 3		45	60		45	70	ns
t ROHNC	RAS High to New Count Valid	Figures 2, 4		30	55		30	55	ns
t _{RLEOC}	RASIN Low to End-of-Count Low	C _L = 50 pF, <i>Figure 2</i>			80			80	ns
tRHEOC	RASIN High to End-of-Count High	C _L = 50 pF, <i>Figure 2</i>			80			80	ns
t RGEOB	RGCK Low to End-of-Burst Low	C _L = 50 pF, <i>Figure 4</i>			95			95	ns
tмсеов	Mode Change to End-of-Burst High	C _L = 50 pF, <i>Figure 4</i>			75			75	ns
t _{RST}	Counter Reset Pulse Width	Figure 2	70			70			ns
t _{CTL}	RF I/O Low to Counter Outputs All Low	Figure 2			100			100	ns
tRFCKL, H	Minimum Pulse Width of RFCK	Figure 9	100			100			ns
т	Period of RAS Generator Clock	Figure 3	100			100			ns
t _{RGCKL}	Minimum Pulse Width Low of RGCK	Figure 3	35			40			ns
t _{RGCKH}	Minimum Pulse Width High of RGCK	Figure 3	35			40			ns
t _{FRQL}	RFCK Low to Forced RFRQ Low	C _L = 50 pF, <i>Figure 3</i>		20	30		20	30	ns
t _{FRQH}	RGCK Low to Forced RFRQ High	C _L = 50 pF, <i>Figure 3</i>		50	75		50	75	ns
t _{RGRL}	RGCK Low to RAS Low	Figure 3	50	65	95	50	65	95	ns
t _{RGRH}	RGCK Low to RAS High	Figure 3	40	60	85	40	60	85	ns
tRQHRF	RFSH Hold Time from RFSH RQST (RF I/O)	Figure 3	2T			2T			ns
t _{RFRH}	RFSH High to RAS High (ending forced RFSH)	See Mode 1 Descrip.	55	80	110	55	80	125	ns
t _{RFSRG}	RFSH Low Set-Up to RGCK Low (Mode 1)	See Mode 1 Descrip.	35			40			ns
tCSCT	CS High to RFSH Counter Valid	Figure 9		55	70		55	75	ns
tCSRL	CS Low to Access RASIN Low	See Mode 5 Descrip.	30			30			ns
TRI-STAT	Ë				.				
^t zH	CS Low to Address Output High from Hi-Z	<i>Figures 9, 12,</i> R1 = 3.5k, R2 = 1.5k		35	60		35	60	ns
^t HZ	CS High to Address Output Hi-Z from High	C _L = 15 pF, <i>Figures 9, 12,</i> R2 = 1k, S1 Open		20	40		20	40	ns
t _{ZL}	CS Low to Address Output Low from Hi-Z	<i>Figures 9, 12,</i> R1 = 3.5k, R2 = 1.5k		35	60		35	60	ns
t _{LZ}	CS High to Address Output Hi-Z from Low	C _L = 15 pF, <i>Figures 9, 12,</i> R1 = 1k, S2 Open		25	50		25	50	ns
^t нzн	CS Low to Control Output High from Hi-Z High	<i>Figures 9, 12,</i> R2 = 750Ω, S1 Open		50	80		50	80	ns
^t ннz	CS High to Control Output Hi-Z High from High	C _L = 15 pF, <i>Figures 9, 12,</i> R2 = 750Ω, S1 Open		40	75		40	75	ns

Switching Characteristics: DP8409A/DP8409A-3 (Continued) $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs including trace capacitance. These values are: Q0-Q8, C1 = 500 pF; RAS0-RAS3, C1 = 150 pF; WE, C_L = 500 pF; CAS, C_L = 600 pF, (unless otherwise noted). See *Figure 11* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k Ω unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Conditions	DP8409A		DP8409A-3			Units	
	T alameter	Conditions	Min	Тур	Max	Min	Тур	Max	onito
TRI-STAT	FE (Continued)								
t _{HZL}	CS Low to Control Output Low from Hi-Z High	<i>Figure 12,</i> S1, S2 Open		45	75		45	75	ns
t _{LHZ}	CS High to Control Output Hi-Z High from Low	C _L = 15 pF, <i>Figure 12,</i> R2 = 750Ω, S1 Open		50	80		50	80	ns

Switching Characteristics: DP8409A-2

 $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs including trace capacitance. These values are: Q0-Q8, CL = 500 pF; RAS0-RAS3, CL = 150 pF; \overline{WE} , $C_L = 500$ pF; \overline{CAS} , $C_L = 600$ pF, (unless otherwise noted). See *Figure 11* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 kΩ unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Conditions		Units		
Symbol	Farameter	Conditions	Min	Тур	Max	
ACCESS						
t _{RICL}	RASIN to CAS Output Delay (Mode 5)	Figure 8a	75	100	130	ns
t _{RICL}	RASIN to CAS Output Delay (Mode 6)	Figures 8a, 8b	65	90	115	ns
t _{RICH}	RASIN to CAS Output Delay (Mode 5)	Figure 8a	40	48	60	ns
t _{RICH}	RASIN to CAS Output Delay (Mode 6)	Figures 8a, 8b	50	63	80	ns
t _{RCDL}	RAS to CAS Output Delay (Mode 5)	Figure 8a		75	100	ns
t _{RCDL}	RAS to CAS Output Delay (Mode 6)	Figures 8a, 8b		65	85	ns
t _{RCDH}	\overline{RAS} to \overline{CAS} Output Delay (Mode 5)	Figure 8a		27	40	ns
t _{RCDH}	\overline{RAS} to \overline{CAS} Output Delay (Mode 6)	Figure 8a		40	65	ns
t _{CCDH}	CASIN to CAS Output Delay (Mode 6)	Figure 8b	40	54	70	ns
t _{RAH}	Row Address Hold Time (Mode 5) (Note 7)	Figure 8a	20			ns
t _{RAH}	Row Address Hold Time (Mode 6) (Note 7)	Figures 8a, 8b	12			ns
t _{ASC}	Column Address Set-Up Time (Mode 5)	Figure 8a	3			ns
tASC	Column Address Set-Up Time (Mode 6)	Figures 8a, 8b	3			ns
t _{RCV}	RASIN to Column Address Valid (Mode 5)	Figure 8a		80	105	ns
t _{RCV}	RASIN to Column Address Valid (Mode 6)	Figures 8a, 8b		70	90	ns
t _{RPDL}	RASIN to RAS Delay	Figures 7a, 7b, 8a, 8b	20	27	35	ns
t _{RPDH}	RASIN to RAS Delay	Figures 7a, 7b, 8a, 8b	15	23	32	ns
t _{APDL}	Address Input to Output Low Delay	Figures 7a, 7b, 8a, 8b		25	40	ns
t _{APDH}	Address Input to Output High Delay	Figures 7a, 7b, 8a, 8b		25	40	ns
tSPDL	Address Strobe to Address Output Low	Figures 7a, 7b		40	60	ns
t _{SPDH}	Address Strobe to Address Output High	Figures 7a, 7b		40	60	ns
t _{ASA}	Address Set-Up Time to ADS	Figures 7a, 7b, 8a, 8b	15			ns
t _{AHA}	Address Hold Time from ADS	Figures 7a, 7b, 8a, 8b	15			ns
t _{ADS}	Address Strobe Pulse Width	Figures 7a, 7b, 8a, 8b	30			ns



DP8409A

Switching Characteristics: DP8409A-2 (Continued) $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs including trace capacitance. These values are: Q0–Q8, C_L = 500 pF; RAS0–RAS3, C_L = 150 pF; WE, C_L = 500 pF; CAS, C_L = 600 pF, (unless otherwise noted). See *Figure 11* for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 k Ω unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Conditions		Units		
Cymbol			Min	Тур	Max	Unite
ACCESS (Co	ontinued)					
tWPDL	WIN to WE Output Delay	Figure 7b	15	25	30	ns
tWPDH	WIN to WE Output Delay	Figure 7b	15	30	60	ns
t _{CRS}	CASIN Set-Up Time to RASIN High (Mode 6)	Figure 8b	35			ns
t _{CPDL}	$\overline{\text{CASIN}}$ to $\overline{\text{CAS}}$ Delay (R/ $\overline{\text{C}}$ Low in Mode 4)	Figure 7b	32	41	58	ns
t _{CPDH}	$\overline{\text{CASIN}}$ to $\overline{\text{CAS}}$ Delay (R/ $\overline{\text{C}}$ Low in Mode 4)	Figure 7b	25	39	50	ns
t _{RCC}	Column Select to Column Address Valid	Figure 7a		40	58	ns
t _{RCR}	Row Select to Row Address Valid	Figures 7a, 7b		40	58	ns
t _{RHA}	Row Address Held from Column Select	Figure 7a	10			ns
t _{CCAS}	R/\overline{C} Low to \overline{CAS} Low (Mode 4 Auto \overline{CAS})	Figure 7a		55	75	ns
t _{DIF1}	Maximum (t _{RPDL} — t _{RHA})	See Mode 4 Descript.			13	ns
t _{DIF2}	Maximum (t _{RCC} - t _{CPDL})	See Mode 4 Descript.			13	ns
REFRESH						
t _{RC}	Refresh Cycle Period	Figure 2	100			ns
t _{RASINL} , H	Pulse Width of RASIN during Refresh	Figure 2	50			ns
t _{RFPDL}	RASIN to RAS Delay during Refresh	Figures 2, 9	35	50	70	ns
t _{RFPDH}	RASIN to RAS Delay during Refresh	Figures 2, 9	30	40	55	ns
t _{RFLCT}	RFSH Low to Counter Address Valid	$\overline{\text{CS}} = X, Figures 2, 3, 4$		47	60	ns
t _{RFHRV}	RFSH High to Row Address Valid	Figures 2, 3		45	60	ns
t _{ROHNC}	RAS High to New Count Valid	Figures 2, 4		30	55	ns
t _{RLEOC}	RASIN Low to End-of-Count Low	C _L = 50 pF, <i>Figure 2</i>			80	ns
t _{RHEOC}	RASIN High to End-of-Count High	C _L = 50 pF, <i>Figure 2</i>			80	ns
t _{RGEOB}	RGCK Low to End-of-Burst Low	C _L = 50 pF, <i>Figure 4</i>			95	ns
t _{MCEOB}	Mode Change to End-of-Burst High	C _L = 50 pF, <i>Figure 4</i>			75	ns
t _{RST}	Counter Reset Pulse Width	Figure 2	70			ns
t _{CTL}	RF I/O Low to Counter Outputs All Low	Figure 2			100	ns
t _{RFCKL} , H	Minimum Pulse Width of RFCK	Figure 9	100			ns
Т	Period of RAS Generator Clock	Figure 3	100			ns
t _{RGCKL}	Minimum Pulse Width Low of RGCK	Figure 3	35			ns
t _{RGCKH}	Minimum Pulse Width High of RGCK	Figure 3	35			ns
tFRQL	RFCK Low to Forced RFRQ Low	$C_L = 50 pF, Figure 3$		20	30	ns

Switching Characteristics: DP8409A-2 (Continued) $V_{CC} = 5.0V \pm 5\%$, 0°C $\leq T_A \leq 70$ °C (unless otherwise noted) (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs including trace capacitance. These values are: Q0-Q8, $C_L = 500 \text{ pF}$; RAS0-RAS3, $C_L = 50$ 150 pF; WE, C1 = 500 pF; CAS, C1 = 600 pF, (unless otherwise noted). See Figure 11 for test load. Switches S1 and S2 are closed unless otherwise noted, and R1 and R2 are 4.7 kΩ unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Conditions	8409A-2			Units	
Symbol	Falanetei	Conditions	Min	Тур	Max		
REFRESH	(Continued)	•		• • • • • •			
t _{FRQH}	RGCK Low to Forced RFRQ High	C _L = 50 pF, <i>Figure 3</i>		50	75	ns	
t _{RGRL}	RGCK Low to RAS Low	Figure 3	50	65	95	ns	
tRGRH	RGCK Low to RAS High	Figure 3	40	60	85	ns	
t _{RQHRF}	RFSH Hold Time from RFSH RQST (RF I/O)	Figure 3	2T			ns	
t _{RFRH}	RFSH High to RAS High (Ending Forced RFSH)	See Mode 1 Descrip.	55	80	110	ns	
tRFSRG	RFSH Low Set-Up to RGCK Low (Mode 1)	See Mode 1 Descrip.	35			ns	
t _{CSCT}	CS High to RFSH Counter Valid	Figure 9		55	70	ns	
tCSRL	CS Low to Access RASIN Low	See Mode 5 Descrip.	30			ns	
t _{ZH}	CS Low to Address Output High from Hi-Z	<i>Figures 9, 12,</i> R1 = 3.5k, R2 = 1.5k	J		60	ns	
tHZ	CS High to Address Output Hi-Z from High	C _L = 15 pF, <i>Figures 9, 12,</i> R2 = 1k, S1 Open	<i>Figures 9, 12,</i> 20		40	ns	
t _{ZL}	CS Low to Address Output Low from Hi-Z	<i>Figures 9, 12,</i> R1 = 3.5k, R2 = 1.5k		35	60	ns	
t _{LZ}	CS High to Address Output Hi-Z from Low	C _L = 15 pF, <i>Figures 9, 12,</i> R1 = 1k, S2 Open	2, 25		50	ns	
thzh	CS Low to Control Output High from Hi-Z High	Figures 9, 12, 50 R2 = 750Ω, S1 Open 50		80	ns		
tHHZ	CS High to Control Output Hi-Z High from High	$C_L = 15 \text{pF},$ 40 7 <i>Figures 9, 12,</i> 40 7 $R2 = 750\Omega, S1 \text{Open}$ 40 7		75	ns		
t _{HZL}	CS Low to Control Output Low from Hi-Z High	Figure 12, 45 75 S1, S2 Open 45 75		75	ns		
t _{LHZ}	CS High to Control Output Hi-Z High from Low	C _L = 15 pF, <i>Figure 12,</i> R2 = 750Ω, S1 Open		50	80	ns	

Input Capacitance $T_A = 25^{\circ}C$ (Notes 2, 6)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
C _{IN}	Input Capacitance ADS, R/C			8		pF
C _{IN}	Input Capacitance All Other Inputs			5		pF

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: All typical values are for $T_A = 25^{\circ}C$ and $V_{CC} = 5.0V$.

Note 3: This test is provided as a monitor of Driver output source and sink current capability. Caution should be exercised in testing these parameters. In testing these parameters, a 15Ω resistor should be placed in series with each output under test. One output should be tested at a time and test time should not exceed 1 second.

Note 4: Input pulse 0V to 3.0V, t_R = t_F = 2.5 ns, f = 2.5 MHz, t_{PW} = 200 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.7V for High and 0.8V for Low.

Note 5: The load capacitance on RF I/O should not exceed 50 pF.

Note 6: Applies to all DP8409A versions unless otherwise specified.

Note 7: The DP8409A-2 device can only be used with memory devices that meet the t_{RAH} specification indicated.

Applications

If external control is preferred, the DP8409A may be used in Mode 0 or 4, as in *Figure 6*.

If basic auto access and refresh are required, then in cases where the user requires the minimum of external complexity, Modes 1 and 5 are ideal, as shown in Figure 13a. The DP843X2 is used to provide proper arbitration between memory access and refresh. This chip supplies all the necessary control signals to the processor as well as the DP8409A. Furthermore, two separate CAS outputs are also included for systems using byte-writing. The refresh clock RFCK may be divided down from either RGCK using an IC counter such as the DM74LS393 or better still, the DP84300 Programmable Refresh Timer. The DP84300 can provide RFCK periods ranging from 15.4 µs to 15.6 µs based on the input clock of 2 to 10 MHz. Figure 13b shows the general timing diagram for interfacing the DP8409A to different microprocessors using the interface controller DP843X2

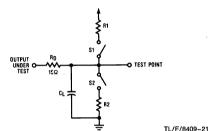


FIGURE 11. Output Load Circuit

If the system is complex, requiring automatic access and refresh, burst refresh, and all-banks auto-write, then more circuitry is required to select the mode. This may be accomplished by utilizing a PAL®. The PAL has two functions. One as an address comparator, so that when the desired port address occurs (programmed in the PAL), the comparator gates the data into a latch, where it is connected to the mode pins of the DP8409A. Hence the mode of the DP8409A can be changed as desired with one PAL chip merely by addressing the PAL location, and then outputting data to the mode-control pins. In this manner, all the automatic modes may be selected, assigning R/C as RFCK always, and CASIN as RGCK always. The output from RF I/O may be used as End-of-Count to an interrupt, or Refresh Request to HOLD or BUS REQUEST. A complex system may use Modes 5 and 1 for automatic access and refresh, Modes 3a and 7 for system initialization, and Mode 2 (autoburst refresh) before and after DMA.

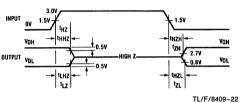


FIGURE 12. Waveform

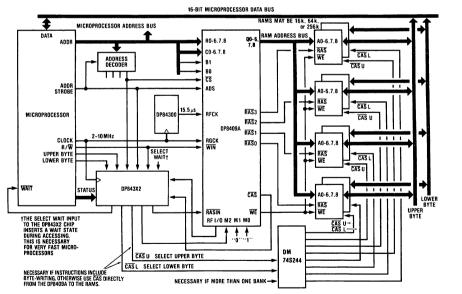
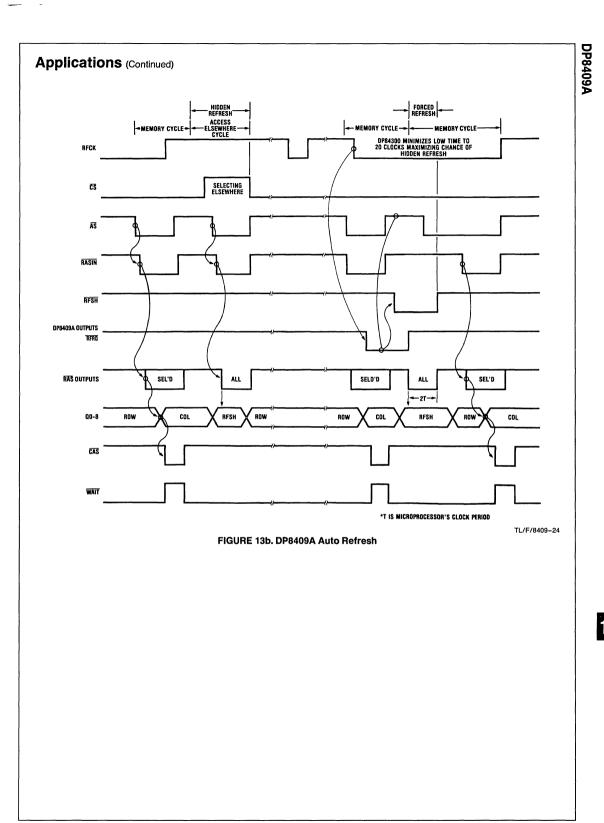


FIGURE 13a. Connecting the DP8409A Between the 16-Bit Microprocessor and Memory

TL/F/8409-23





PRELIMINARY

DP8417/NS32817, 8418/32818, 8419/32819, 8419X/ 32819X 64k, 256k Dynamic RAM Controller/Drivers

General Description

The DP8417/8418/8419/8419X represent a family of 256k DRAM Controller/Drivers which are designed to provide "No-Waitstate" CPU interface to Dynamic RAM arrays of up to 2 Mbytes and larger. Each device offers slight functional variations of the DP8419 design which are tailored for different system requirements. All family members are fabricated using National's new oxide isolated Advanced Low power Schottky (ALS) process and use design techniques which enable them to significantly out-perform all other LSI or discrete alternatives in speed, level of integration, and power consumption.

Each device integrates the following critical 256k DRAM controller functions on a single monolithic device: ultra precise delay line; 9-bit refresh counter; fall-through row, column, and bank select input latches; Row/Column address muxing logic; on-board high capacitive-load RAS, CAS, and Write Enable & Address output drivers; and, precise control signal timing for all the above.

There are four device options of the basic DP8419 Controller. The DP8417 is pin and function compatible with the DP8419 except that its outputs are TRI-STATE®. The DP8418 changes one pin and is specifically designed to offer an optimum interface to 32 bit microprocessors. The DP8419X is functionally identical to the DP8419, but is available in a 52-pin DIP package which is upward pin compatible with National's new DP8429D 1 Mbit DRAM Controller/ Driver.

Each device is available in plastic DIP, Ceramic DIP, and Plastic Chip Carrier (PCC) packaging. (Continued)

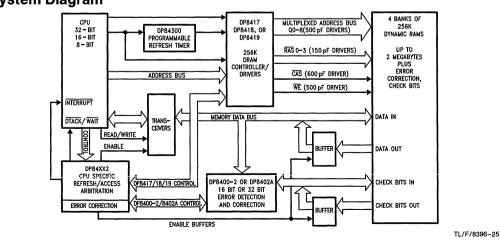
Operational Features

- Makes DRAM Interface and refresh tasks appear virtually transparent to the CPU, making DRAMs as easy to use as static RAMs
- Specifically designed to eliminate CPU wait states up to 10 MHz or beyond
- Eliminates 15 to 20 SSI/MSI components for significant board real estate reduction, system power savings and the elimination of chip-to-chip AC skewing
- On-board ultra precise delay line
- On-board high capacitive RAS, CAS, WE, and address drivers (specified driving 88 DRAMs directly)
- AC specified for directly addressing up to 8 Megabytes
- Low power/high speed bipolar oxide isolated process
- Upward pin and function compatible with new DP8428/ DP8429 1 Mbit DRAM controller drivers
- Downward pin and function compatible with DP8408A/ DP8409A 64k/256k DRAM controller/drivers
- 4 user selectable modes of operation for Access and Refresh (2 automatic, 2 external)

Contents

- System and Device Block Diagrams
- Recommended Companion Components
- Device Connection Diagrams and Pin Definitions
- Family Device Differences (DP8419 vs DP8409A, 8417, 8418, 8419X)
- Mode of Operation (Descriptions and Timing Diagrams)
- Application Description and Diagrams
- DC/AC Electrical Specifications, Timing Diagrams and Test Conditions

System Diagram



General Description (Continued)

In order to specify each device for "true" worst case operating conditions, all timing parameters are guaranteed while the chip is driving the capacitive load of 88 DRAMs including trace capacitance. The chip's delay timing logic makes use of a patented new delay line technique which keeps A.C. skew to ± 3 ns over the full V_{CC} range of $\pm 10\%$ and temperature range of -55° C to $+125^\circ$ C. The DP8417, DP8418, DP8419, and DP8419X guarantee a maximum RASIN to CASOUT delay of 80 ns or 70 ns even while driving a 2 Mbyte memory array with error correction check bits included. Speed selected options of these devices are shown in the switching characteristics section of this document.

With its four independent TAS outputs and nine multiplexed address outputs, the DP8419 can support up to four banks of 16k, 64k or 256k DRAMs. Two bank select pins, B1 and B0, are decoded to activate one of the TAS signals during

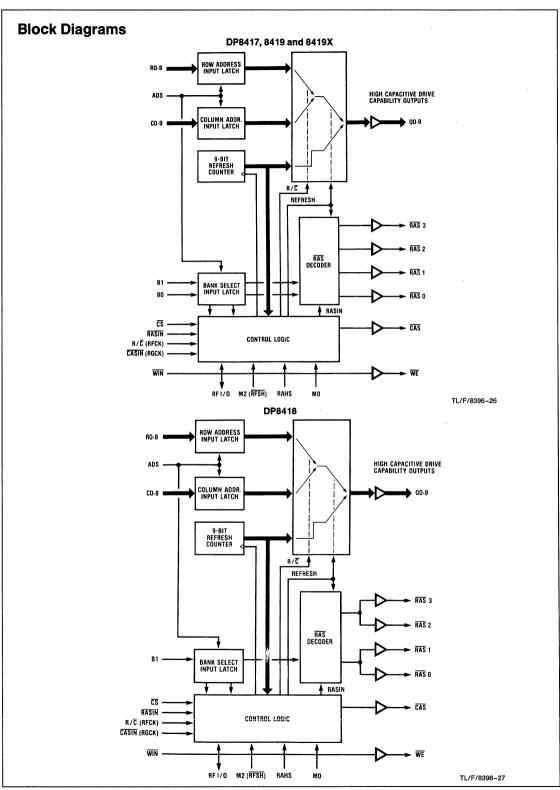
an access, leaving the three non-selected banks in the standby mode (less than one tenth of the operating power) with data outputs in TRI-STATE.

The DP8419 has two mode-select pins, allowing for two refresh modes and two access modes. Refresh and access timing may be controlled either externally or automatically. The automatic modes require a minimum of input control signals.

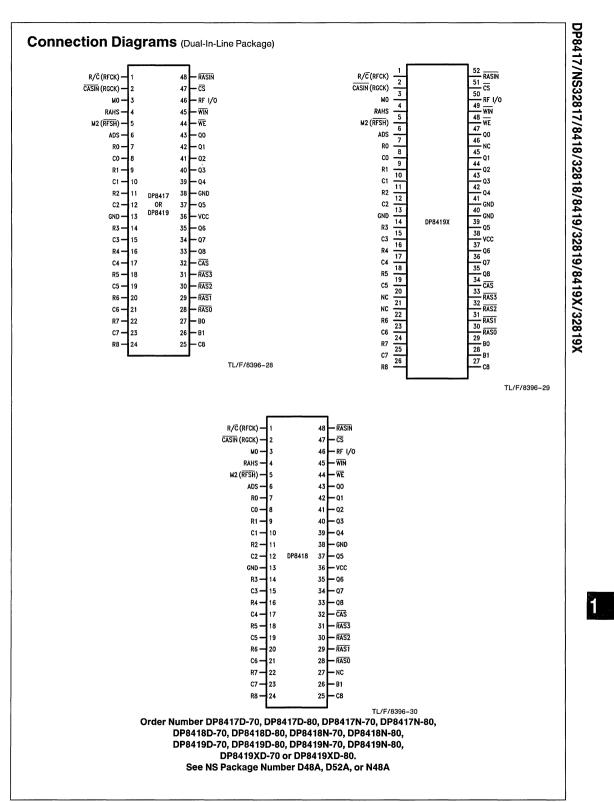
A refresh counter is on-chip and is multiplexed with the row and column inputs. Its contents appear at the address outputs of the DP8419 during any refresh, and are incremented at the completion of the refresh. Row/Column and bank address latches are also on-chip. However, if the address inputs to the DP8419 are valid throughout the duration of the access, these latches may be operated in the fallthrough mode.

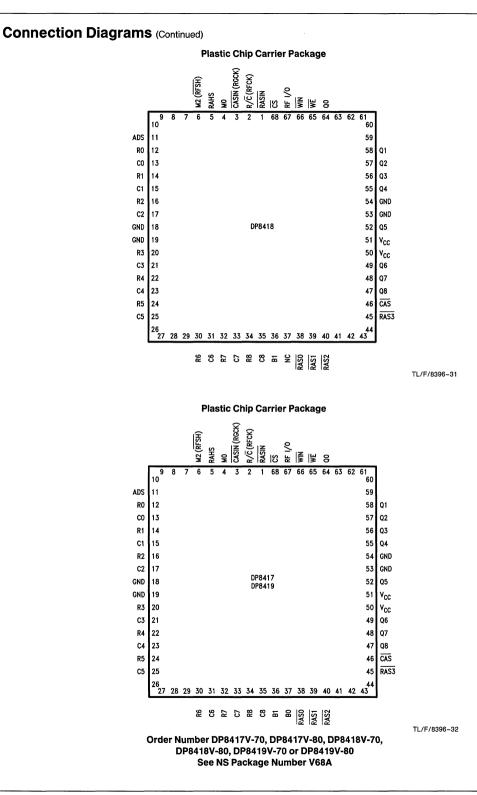
Device #	Function
DP84300	Programmable Refresh Timer for DP84xx DRAM Controller
DP84412	NS32008/16/32 to DP8409A/17/18/19/28/29 Interface
DP84512	NS32332 to DP8417/18/19/28/29 Interface
DP84322	68000/08/10 to DP8409A/17/18/19/28/29 Interface (up to 8 MHz)
DP84422	68000/08/10 to DP8409A/17/18/19/28/29 Interface (up to 12.5 MHz)
DP84522	68020 to DP8417/18/19/28/29 Interface
DP84432	8086/88/186/188 to DP8409A/17/18/19/28/29 Interface
DP84532	80286 to DP8409A/17/18/19/28/29 Interface
DP8400-2	16-bit Expandable Error Checker/Corrector
DP8400-4	16-bit Expandable Error Checker/Corrector
DP8402A	32-bit Error Detector and Corrector (EDAC)

System Companion Components



DP8417/NS32817/8418/32818/8419/32819/8419X/32819X





Family Device Differences

The DP8417 is identical to the DP8419 with the exception that its RAS, CAS, WE and Q (Multiplexed Address) outputs are TRI-STATE when \overline{CS} (Chip Select) is high and the chip is not in a refresh mode. This feature allows access to the same DRAM array through multiple DRAM Controller/Driver DP8417s. All AC specifications are the same as the DP8419 except t_{CSRLO} which is 34 ns for the DP8417 versus 5 ns for the DP8419. Separate delay specifications for the TRI-STATE timing paths are provided in the AC tables of this data sheet

DP8418 vs DP8419

The DP8418 DYNAMIC RAM CONTROLLER/DRIVER is identical to the DP8419 with the exception of two functional differences incorporated to improve performance with 32-bit microprocessors.

- 1) Pin 26 (B1) is used to enable/disable a pair of RAS outputs, and pin 27 (B0 on the DP8419) is a no connect. When B1 is low, RAS0 and RAS1 are enabled such that they both go low during an access. When B1 is high, RAS2 and RAS3 are enabled. This feature is useful when driving words to 32 bits or more since each RAS would be driving only one half of the word. By distributing the load on each RAS line in this way, the DP8418 will meet the same AC specifications driving 2 banks of 32 DRAMs each as the DP8419 does driving 4 banks of 16 bits each.
- 2) The hidden refresh function available on the DP8419 has been disabled in order to reduce the amount of setup time necessary from CS going low to RASIN going low during an access of DRAM. This parameter, called t_{CSRL1}, is 5 ns for the DP8418 whereas it is 34 ns for the DP8419. The hidden refresh function only allows a very small increase in system performance, at best, at microprocessor frequencies of 10 MHz and above.

DP8419 vs DP8409A

The DP8419 High Speed DRAM Controller/Driver combines the most popular memory control features of the DP8408A/9A DRAM Controller/Driver with the high speed of bipolar oxide isolation processing.

The DP8419 retains the high capacitive-load drive capability of the DP8408A/9A as well as its most frequently used access and refresh modes, allowing it to directly replace the DP8408A/9A in applications using only modes 0, 1, 4 and 5. Thus, the DP8419 will allow most DP8408A/9A users to directly upgrade their system by replacing their old controller chip with the DP8419.

The highest priority of the DP8419 is speed. By peforming the DRAM address multiplexing, control signal timing and high-capacitive drive capability on a single chip, propagation delay skews are minimized. Emphasis has been placed on reducing delay variation over the specified supply and temperature ranges.

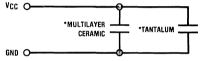
Except for the following, a DP8419 will operate essentially the same as a DP8409A.

- 1) The DP8419 has significantly faster AC performance.
- 2) The DP8419 can replace the DP8409A in applications which use modes 0, 1, 4, and 5. Modes 2, 3, 6, and 7 of the DP8409A are not available on the DP8419.

- 3) Pin 4 on the DP8419 is RAHS instead of M1, as on the DP8409A, and allows for two choices of $t_{\rm RAH}$ in mode 5.
- 4) RFI/O does not function as an end-of-count signal in Mode 0 on the DP8419 as it does on the DP8409A.
- 5) DP8419 address and control outputs do not TRI-STATE when CS is high as on the DP8409A. DP8419 control outputs are active high when CS is high (unless refreshing).

Pin Definitions

 $V_{CC},$ GND, GND – V_{CC} = 5V \pm 10%. The three supply pins have been assigned to the center of the package to reduce voltage drops, both DC and AC. There are two ground pins to reduce the low level noise. The second ground pin is located two pins from V_{CC} , so that decoupling capacitors can be inserted directly next to these pins. It is important to adequately decouple this device, due to the high switching currents that will occur when all 9 address bits change in the same direction simultaneously. A recommended solution would be a 1 μ F multilayer ceramic capacitor in parallel with a low-voltage tantalum capacitor, both connected as close as possible to V_{CC} and GND to reduce lead inductance. See Figure below.



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*Capacitor values should be chosen depending on the particular application.

R0-R8: Row Address Inputs.

C0-C8: Column Address Inputs.

Q0-Q8: Multiplexed Address Outputs - This address is selected from the Row Address Input Latch, the Column Address Input Latch or the Refresh Counter.

RASIN: Row Address Strobe Input - RASIN directly controls the selected RAS output when in an access mode and all RAS outputs during hidden or external refresh.

 $\mathbf{R}/\overline{\mathbf{C}}$ (**RFCK**) - In the auto-modes this pin is the external refresh clock input; one refresh cycle should be performed each clock period. In the external access mode it is Row/ Column Select Input which enables either the row or column address input latch onto the output bus.

CASIN (RGCK) - In the auto-modes this pin is the RAS Generator Clock input. In external access mode it is the Column Address Strobe input which controls CAS directly once columns are enabled on the address outputs.

ADS: Address (Latch) Strobe Input - Row Address, Column Address, and Bank Select Latches are fall-through with ADS high; latching occurs on high-to-low transition of ADS.

CS: Chip Select Input - When high, CS disables all accesses. Refreshing, however, in both modes 0 and 1 is not affected by this pin.

M0, M2 (RFSH): Mode Control Inputs - These pins select one of the four available operational modes of the DP8419 (see Table III).

RFI/O: Refresh Input/Output - In the auto-modes this pin is the Refresh Request Output. It goes low following RFCK

Pin Definitions (Continued)

indicating that no hidden refresh was performed while RFCK was high. When this pin is set low by an external gate the on-chip refresh counter is reset to all zeroes.

WIN: Write Enable Input.

WE: Write Enable Output - WE follows WIN unconditionally.

RAHS: Row Address Hold Time Select - Selects the t_{RAH} to be generated by the DP8419 delay line to allow use with fast or slow DRAMs.

 $\label{eq:cases} \hline \textbf{CAS: Column Address Strobe Output - } In mode 5 and in mode 4 with CASIN low before R/C goes low, CAS goes low automatically after the column address is valid on the address outputs. In mode 4 CAS follows CASIN directly after R/C goes low, allowing for nibble accessing. CAS is always high during refresh.$

RAS 0-3: Row Address Strobe Outputs - The enabled RAS output (see Table II) follows RASIN directly during an access. During refresh, all RAS outputs are enabled.

B0, B1: Bank Select Inputs - These pins are decoded to enable one of the four RAS outputs during an access (see Table I and Table II).

TABLE I. DP8417, DP8419, DP8419X Memory Bank Decode

	Select by ADS)	Enabled RAS _n
B1	B0	
0	0	RAS ₀
0	1	RAS ₁
1	0	RAS ₂
1	1	RAS ₃

TABLE II. DP8418 Memory Bank Decode

	Select I by ADS)	Enabled RAS _n
B1	NC	
0	X	\overline{RAS}_0 and \overline{RAS}_1 \overline{RAS}_2 and \overline{RAS}_3
1	X	RAS ₂ and RAS ₃

Conditions for All Modes

INPUT ADDRESSING

The address block consists of a row-address latch, a column-address latch, and a resettable refresh counter. The address latches are fall-through when ADS is high and latch when ADS goes low. If the address bus contains valid addresses until after CAS goes low at the end of the memory cycle, ADS can be permanently high. Otherwise ADS must go low while the addresses are still valid.

DRIVE CAPABILITY

The DP8419 has timing parameters that are specified driving the typical capacitance (including traces) of 88, 5V-only DRAMs. Since there are 4 $\overrightarrow{\text{RAS}}$ outputs, each is specified driving one-fourth of the total memory. CAS, $\overrightarrow{\text{WE}}$ and the address outputs are specified driving all 88 DRAMs.

The graph in *Figure 10* may be used to determine the slight variations in timing parameters, due to loading conditions other than 88 DRAMs.

Because of distributed trace capacitance and inductance and DRAM input capacitance, current spikes can be created, causing overshoots and undershoots at the DRAM inputs that can change the contents of the DRAMs or even destroy them. To reduce these spikes, a damping resistor (low inductance, carbon) should be inserted between the DP8419 outputs and the DRAMs, as close as possible to the DP8419. The damping resistor values may differ depending on how heavily an output is loaded. These resistors should be determined by the first prototypes (not wirewrapped due to the larger distributed capacitance and inductance). Resistors should be chosen such that the transition on the control outputs is critically damped. Typical values will be from 15Ω to 100Ω , with the lower values being used with the larger memory arrays. Note that AC parameters are specified with 15Ω damping resistors. For more information see AN-305 "Precautions to Take When Driving Memories".

DP8419 DRIVING ANY 16k, 64k or 256k DRAMs

The DP8419 can drive any 16k, 64k or 256k DRAMs. All 16k DRAMs use basically the same configuration, including the 5V-only version. Hence, in most applications, different manufacturers' DRAMs are interchangeable (for the same supply-rail chips), and the DP8419 can drive them all (see *Figure 1a*).

There are three basic configurations for the 5V-only 64k DRAMs: a 128-row by 512-column array with an on-RAM refresh counter, a 128-row by 512-column array with no on-RAM refresh counter, and a 256-row by 256-column array with no on-RAM refresh counter. The DP8419 can drive all three configurations, and allows them all to be interchange-able (as shown in *Figures 1b* and *1c*), providing maximum flexibility in the choice of DRAMs. Since the 9-bit on-chip refresh counter can be used as a 7-bit refresh counter for the 128-row configuration, or as an 8-bit refresh counter for the 256-row configuration, the on-RAM refresh counter, if present, is never used.

256k DRAMs require all 18 of the DP8419's address inputs to select one memory location within the DRAM. RAS-only refreshing with the nine-bit refresh-counter on the DP8419 makes CAS before RAS refreshing, available on 256k DRAMs, unnecessary.

READ, WRITE AND READ-MODIFY-WRITE CYCLES

The output signal, \overline{WE} , determines what type of memory access cycle the memory will perform. If \overline{WE} is kept high while \overline{CAS} goes low, a read cycle occurs. If \overline{WE} goes low before \overline{CAS} goes low, a write cycle occurs and data at DI (DRAM input data) is written into the DRAM as \overline{CAS} goes low. If \overline{WE} goes low later than t_{CWD} after \overline{CAS} goes low, first a read occurs and DO (DRAM output data) becomes valid, then data DI is written into the same address in the DRAM as \overline{WE} goes low. In this read-modify-write case, DI and DO cannot be linked together. \overline{WE} always follows \overline{WIN} directly to determine the type of access to be performed.

POWER-UP INITIALIZE

When V_{CC} is first applied to the DP8419, an initialize pulse clears the refresh counter and the internal control flip-flops.

Mode Features Summary

- 4 modes of operation: 2 access and 2 refresh
- Automatic or external control selected by the user
- Auto access mode provides RAS, row to column change, and then CAS automatically
- Choice between two different values of t_{RAH} in auto-access mode
- CAS controlled independently in external control mode, allowing for nibble mode accessing
- Automatic refreshing can make refreshes transparent to the system
- CAS is inhibited during refresh cycles

DP8419 Mode Descriptions

MODE 0-EXTERNALLY CONTROLLED REFRESH

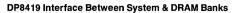
Figure 2 shows the Externally Controlled Refresh timing. In this mode the refresh counter contents are multiplexed to the address outputs. All \overrightarrow{RAS} outputs are enabled to follow \overrightarrow{RASIN} so that the row address indicated by the refresh counter is refreshed in all DRAM banks when \overrightarrow{RASIN} goes low. The refresh counter increments when \overrightarrow{RASIN} goes high. \overrightarrow{RFSH} should be held low at least until \overrightarrow{RASIN} goes high (they may go high simultaneously) so that the refresh address remains valid and all \overrightarrow{RAS} outputs remain enabled throughout the refresh.

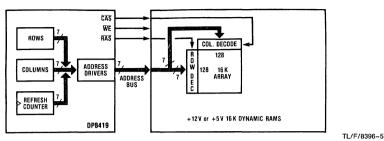
A burst refresh may be performed by holding RFSH low and toggling RASIN until all rows are refreshed. It may be useful in this case to reset the refresh counter just prior to beginning the refresh. The refresh counter resets to all zeroes when RFI/O is pulled low by an external gate. The refresh counter always counts to 511 before rolling over to zero. If there are 128 or 256 rows being refreshed then Q7 or C2 respectively, going high may be used as an end-of-burst indicator.

In order that the refresh address is valid on the address outputs prior to the RAS lines going low, RFSH must go low before RASIN. The setup time required is given by t_{RFLRL} in the Switching Characteristics. This parameter may be adjusted using *Figure 10* for loading conditions other than those specified.

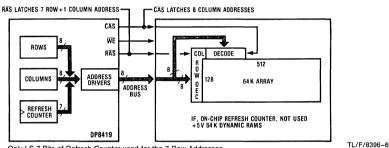
TABLE III. DP8419 Mode Select Options

Mode	(RFSH) M2	мо	Mode of Operation
0	0	0	Externally Controlled Refresh
1	0	1	Auto Refresh-Forced
4	1	0	Externally Controlled Access
5	1	1	Auto Access (Hidden Refresh)









Only LS 7 Bits of Refresh Counter used for the 7 Row Addresses.

MSB not used but can toggle.

FIGURE 1b. DP8419 with 128 Row x 512 Column 64k DRAM

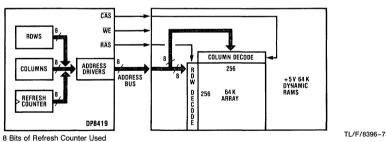
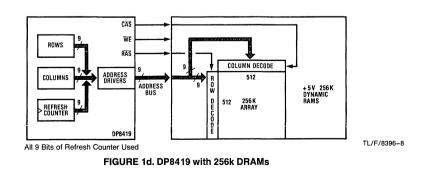
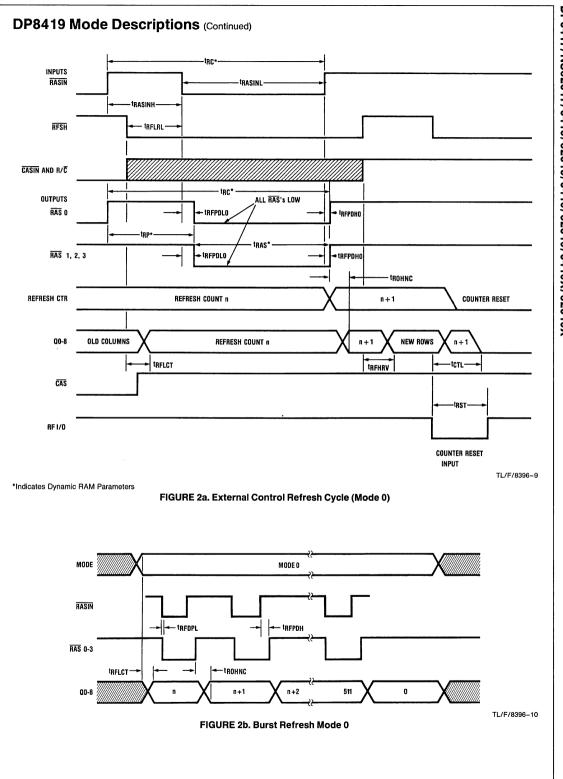


FIGURE 1c. DP8419 with 256 Row x 256 Column 64k DRAM





DP8417/NS32817/8418/32818/8419/32819/8419X/32819X

MODE 1-AUTOMATIC FORCED REFRESH

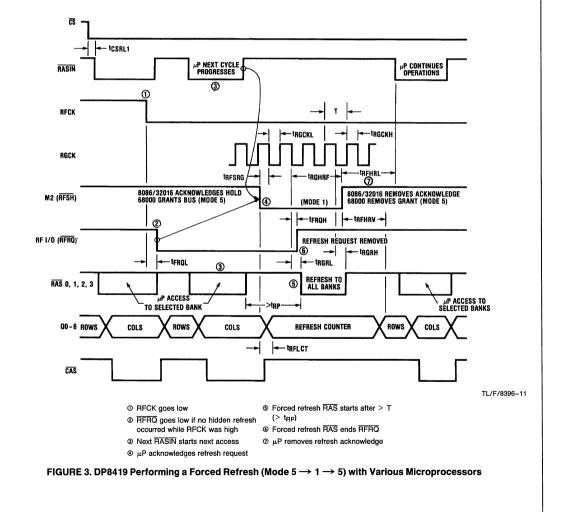
In Mode 1 the R/\overline{C} (RFCK) pin becomes RFCK (refresh cycle clock) and the \overline{CASIN} (RGCK) pin becomes RGCK (RAS generator clock). If RFCK is high and Mode 1 is entered then the chip operates as if in MODE 0 (externally controlled refresh), with all RAS outputs following RASIN. This feature of Mode 1 may be useful for those who want to use Mode 5 (automatic access) with externally controlled refresh. By holding RFCK permanently high one need only toggle M2 (RFSH) to switch from Mode 5 to external refresh. As with Mode 0, RFI/O may be pulled low by an external gate to reset the refresh counter.

When using Mode 1 as automatic refresh, RFCK must be an input clock signal. One refresh should occur each period of RFCK. If no refresh is performed while RFCK is high, then when RFCK goes low RFI/O immediately goes low to indicate that a refresh is requested. (RFI/O may still be used to reset the refresh counter even though it is also used as a refresh request pin, however, an open-collector gate should

be used to reset the counter in this case since RFI/O is forced low internally for a request).

After receiving the refresh request the system must allow a forced refresh to take place while RFCK is low. External logic can monitor RFRQ (RFI/O) so that when RFRQ goes low this logic will wait for the access currently in progress to be completed before pulling M2 (RFSH) low to put the DP8419 in mode 1. If no access is taking place when RFRQ occurs, then M2 may immediately go low. Once M2 is low, the refresh counter contents appear at the address outputs and RAS is generated to perform the refresh.

An external clock on RGCK is required to derive the refresh RAS signals. On the second falling edge of RGCK after M2 is low, all RAS lines go low. They remain low until two more falling edges of RGCK. Thus RAS remains high for one to two periods of RGCK after M2 goes low, and stays low for two periods. In order to obtain the minimum delay from M2 going low to RAS going low, M2 should go low t_{RFSRG} before the falling edge of RGCK.



The Refresh Request on RFI/O is terminated as \overline{RAS} goes low. This signal may be used to end the refresh earlier than it normally would as described above. If M2 is pulled high while the \overline{RAS} lines are low, then the \overline{RAS} go high $t_{\rm RFRH}$ later. The designer must be careful, however, not to violate the minimum \overline{RAS} low time of the DRAMs. He must also guarantee that the minimum \overline{RAS} precharge time is not violated during a transition from mode 1 to mode 5 when an access is desired immediately following a refresh.

If the processor tries to access memory while the DP8419 is in mode 1, WAIT states should be inserted into the processor cycles until the DP8419 is back in mode 5 and the desired access has been accomplished (see *Figure 9*).

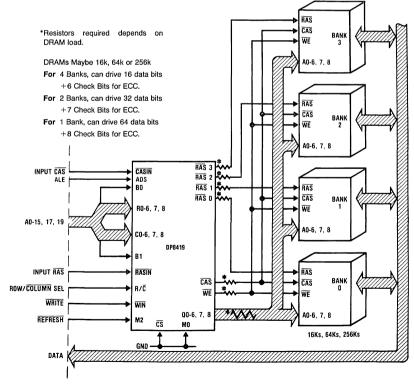
Instead of using WAIT states to delay accesses when refreshing, HOLD states could be used as follows. $\overline{\text{RFRQ}}$ could be connected to a HOLD or Bus Request input to the system. When convenient, the system acknowledges the HOLD or Bus Request by pulling M2 low. Using this scheme, HOLD will end as the RAS lines go low (RFI/O goes high). Thus, there must be sufficient delay from the time HOLD goes high to the DP8419 returning to mode 5, so that the RAS low time of the DRAMs isn't violated as described earlier (see *Figure 3* for mode 1 refresh with Hold states).

To perform a forced refresh the system will be inactive for about four periods of RGCK. For a frequency of 10 MHz, this is 400 ns. To refresh 128 rows every 2 ms an average of about one refresh per 16 μ s is required. With a RFCK period of 16 μ s and RGCK period of 100 ns, DRAM accesses are delayed due to refresh only 2.5% of the time. If using the Hidden Refresh available in mode 5 (refreshing with RFCK high) this percentage will be even lower.

MODE 4 - EXTERNALLY CONTROLLED ACCESS

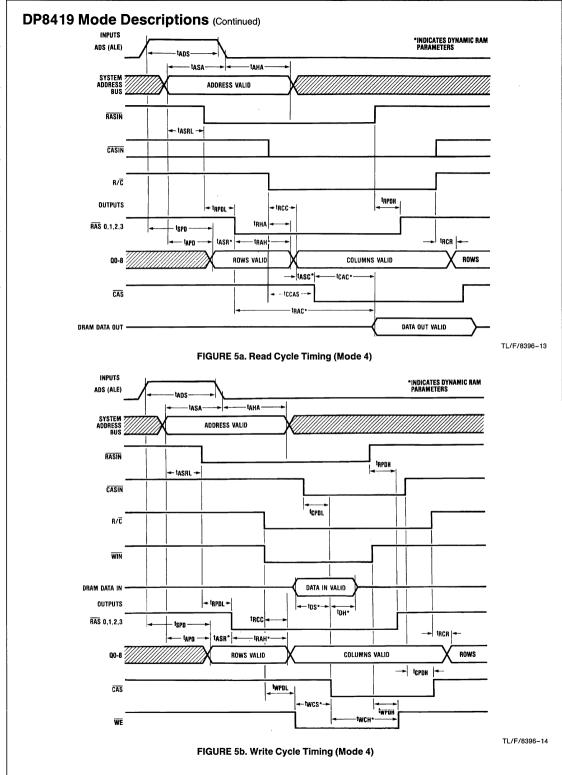
In this mode all control signal outputs can be controlled directly by the corresponding control input. The enabled RAS output follows RASIN, CAS follows CASIN (with R/C low), WE follows WIN and R/C determines whether the row or the column inputs are enabled to the address outputs (see *Figure 4*).

With R/ \overline{C} high, the row address latch contents are enabled onto the address bus. \overline{RAS} going low strobes the row address into the DRAMs. After waiting to allow for sufficient row-address hold time (t_{RAH}) after \overline{RAS} goes low, R/ \overline{C} can go low to enable the column address latch contents onto the address bus. When the column address is valid, \overline{CAS} going low will strobe it into the DRAMs. \overline{WIN} determines whether the cycle is a read, write or read-modify-write access. Refer to *Figures 5a* and *5b* for typical Read and Write timing using mode 4.



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Page or Nibble mode may be performed by toggling CASIN once the initial access has been completed. In the case of page mode the column address must be changed before CASIN goes low to access a new memory location (see *Figure 5c*). Parameter t_{CPdif} has been specified in order that users may easily determine minimum CAS pulse widths when CASIN is toggling.

AUTOMATIC CAS GENERATION

 $\begin{array}{l} \hline CAS \text{ is held high when } \mathsf{R}/\overline{\mathsf{C}} \text{ is high even if } \overline{\mathsf{CASIN}} \text{ is low. If} \\ \hline CASIN \text{ is low when } \mathsf{R}/\overline{\mathsf{C}} \text{ goes low, } \overline{\mathsf{CAS}} \text{ goes low automatically, } \\ t_{\mathsf{ASC}} \text{ after the column address is valid. This feature eliminates the need for an externally derived } \hline CASIN \text{ signal to control } \hline CAS \text{ when performing a simple access } (Figure 5a demonstrates Auto-CAS generation in mode 4). Page or nibble accessing may be performed as shown in Figure 5c even if } \hline CAS \text{ is generated automatically for the initial access.} \end{array}$

FASTEST MEMORY ACCESS

The fastest mode 4 access is achieved by using the automatic \overline{CAS} feature and external delay line to generate the required delay between \overline{RASIN} and R/\overline{C} . The amount of delay required depends on the minimum t_{RAH} of the DRAMs being used. The DP8419 parameter t_{DIF1} has been specified in order that the delay between \overline{RASIN} and R/\overline{C} may be minimized.

t_{DIF1} = MAXIMUM (t_{RPDL} - t_{RHA})

where $t_{RPDL} = \overline{RASIN}$ to \overline{RAS} delay

and t_{RHA} = row address held from R/ \overline{C} going low. The delay between \overline{RASIN} and R/ \overline{C} that guarantees the specified DRAM t_{RAH} is given by

MINIMUM **RASIN** to $R/\overline{C} = t_{DIF1} + t_{RAH}$.

Example

In an application using DRAMs that require a minimum t_{RAH} of 15 ns, the following demonstrates how the maximum $\overline{\text{RASIN}}$ to $\overline{\text{CAS}}$ time is determined.

With t_{DIF1} (from Switching Characteristics) = 7 ns,

 \overline{RASIN} to R/\overline{C} delay = 7 ns + 15 ns = 22 ns.

A delay line of 25 ns will be sufficient.

With Auto- \overline{CAS} generation, the maximum delay from R/\overline{C} to \overline{CAS} (loaded with 600 pF) is 46 ns. Thus the maximum \overline{RASIN} to \overline{CAS} time is 71 ns, under the given conditions.

With a maximum $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ time (t_{RPDL}) of 20 ns, the maximum $\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ time is about 51 ns. Most DRAMs with a 15 ns minimum t_{RAH} have a maximum t_{RCD} of about 60 ns. Thus, memory accesses are likely to be $\overline{\text{RAS}}$ limited instead of $\overline{\text{CAS}}$ limited. In other words, memory access time is limited by DRAM performance, not controller performance.

REFRESHING IN CONJUNCTION WITH MODE 4

If using mode 4 to access memory, mode 0 (externally controlled refresh) must be used for all refreshing.

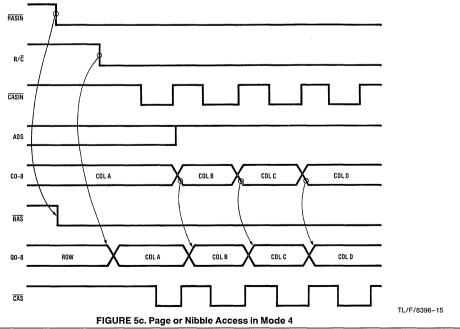
MODE 5 – AUTOMATIC ACCESS WITH HIDDEN RE-FRESHING CAPABILITY

Automatic-Access has two advantages over the externally controlled access (mode 4). First, RAS, CAS and the row to column change are all derived internally from one input signal, RASIN. Thus the need for an external delay line (see mode 4) is eliminated.

Secondly, since R/C and \overline{CASIN} are not needed to generate the row to column change and \overline{CAS} , these pins can be used for the automatic refreshing function.

AUTOMATIC ACCESS CONTROL

Mode 5 of the DP8419 makes accessing Dynamic RAM nearly as easy as accessing static RAM. Once row and column addresses are valid (latched on the DP8419 if necessary), $\overrightarrow{\text{RASIN}}$ going low is all that is required to perform the memory access.



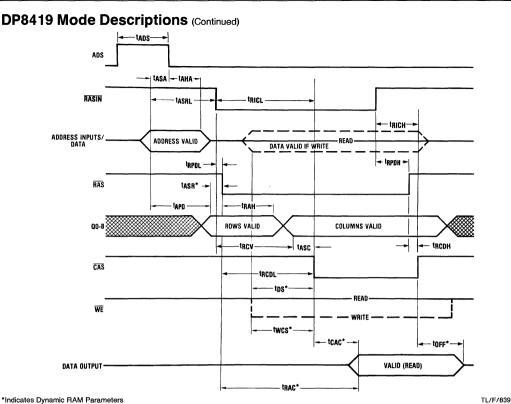
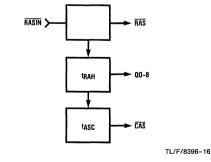


FIGURE 6. Mode 5 Timing

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(Refer to Figure 6) In mode 5 the selected RAS follows RASIN immediately, as in mode 4, to strobe the row address into the DRAMs. The row address remains valid on the DP8419 address outputs long enough to meet the t_{RAH} requirement of the DRAMs (pin 4, RAHS, of the DP8419 allows the user two choices of t_{RAH}). Next, the column address replaces the row address on the address outputs and CAS goes low to strobe the columns into the DRAMs. WIN determines whether a read, write or read-modify-write is done.

The diagram below illustrates mode 5 automatic control signal generation.



REFRESHING IN CONJUNCTION WITH MODE 5

When using mode 5 to perform memory accesses, refreshing may be accomplished:

externally (in mode 0 or mode 1) (a)

- (b) by a combination of mode 5 (hidden refresh) and mode 1 (auto-refresh)
- by a combination of mode 5 and mode 0 or (c)

Externally Controlled Refreshing in Mode 0 or Mode 1 (a)

All refreshing may be accomplished using external refreshes in either mode 0 or mode 1 with R/C (RFCK) tied high (see mode 0 and mode 1 descriptions). If this is desired, the system determines when a refresh will be performed, puts the DP8419 in the appropriate mode, and controls the RAS signals directly with RASIN. The on-chip refresh counter is enabled to the address outputs of the DP8419 when the refresh mode is entered, and increments when RASIN goes high at the completion of the refresh.

(b) Mode 5 Refreshing (hidden) with Mode 1 refreshing (auto)

(Refer to Figure 7a) If RFCK is tied to a clock (see mode 1 description), RFI/O becomes a refresh request output and goes low following RFCK going low if no refresh occurred while RFCK was high. Refreshes may be performed in mode 5 when the DP8419 is not selected for access (CS is high) and RFCK is high. If these conditions exist the refresh counter contents appear on the DP8419 address outputs and all RAS lines follow RASIN so that if RASIN goes low (an access other than through the DP8419 occurs), all RAS lines go low to perform the refresh. The DP8419 allows only one refresh of this type for each period of RFCK, since RFCK should be fast enough such that one refresh per period is sufficient to meet the DRAM refresh requirement.

Once it is started, a hidden refresh will continue even if RFCK goes low. However, $\overline{\text{CS}}$ must be high throughout the refresh (until $\overline{\text{RASIN}}$ goes high).

These hidden refreshes are valuable in that they do not delay accesses. When determining the duty cycle of RFCK, the high time should be maximized in order to maximize the probability of hidden refreshes. If a hidden refresh doesn't happen, then a refresh request will occur on RFI/O when RFCK goes low. After receiving the request, the system must perform a refresh while RFCK is low. This may be done by going to mode 1 and allowing an automatic refresh (see mode 1 description). This refresh must be completed while RFCK is low, thus the RFCK low time is determined by the worst-case time required by the system to respond to a refresh request.

(c) Mode 5 Refresh (Hidden Refresh) with mode 0 Refresh (External Refresh)

This refresh scheme is identical to that in (b) except that after receiving a refresh request, mode 0 is entered to do the refresh (see mode 0 description). The refresh request is terminated (RFI/O goes high) as soon as mode 0 is entered. This method requires more control than using mode 1 (auto-refresh), however, it may be desirable if the mode 1 refresh time is considered to be excessive.

Example

Figure 7b demonstrates how a system designer would use the DP8419 in mode 5 based on certain characteristics of his system.

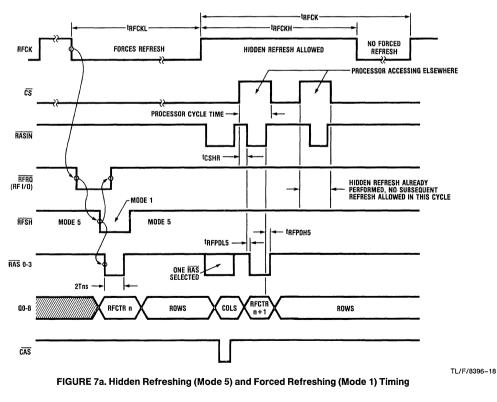
System Characteristics:

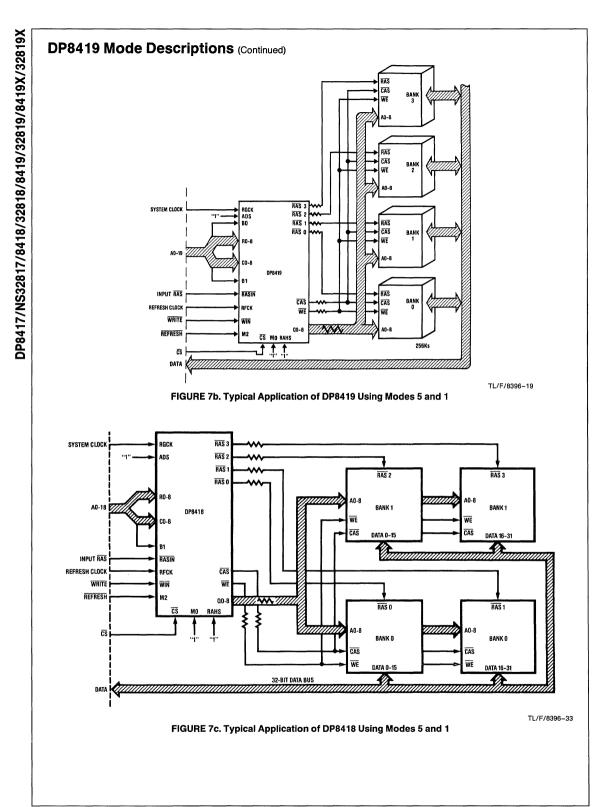
- 1) DRAM used has min $t_{\hbox{\scriptsize RAH}}$ requirement of 15 ns and min $t_{\hbox{\scriptsize ASR}}$ of 0 ns
- 2) DRAM address is valid from time $T_{\rm V}$ to the end of the memory cycle
- 3) four banks of twenty-two 256K memory chips each are being driven

Using the DP8419 (see Figure 7b):

- 1) Tie pin 4 (RAHS) high to guarantee a 15 ns minimum t_{RAH} which is sufficient for the DRAMs being used
- 2) Generate $\overline{\text{RASIN}}$ no earlier than time T_V + t_{ASRL} (see switching characteristics), so that the row address is valid on the DRAM address inputs before $\overline{\text{RAS}}$ occurs
- 3) Tie ADS high since latching the DRAM address on the DP8419 is not necessary
- 4) Connect the first 18 system address bits to R0-R8 and C0-C8, and bits 19 and 20 to B0 and B1
- 5) Connect each RAS output of the DP8419 to the RAS inputs of the DRAMs of one bank of the memory array; connect Q0-Q8 of the DP8419 to A0-A8 of all DRAMs; connect CAS of the DP8419 to CAS of all the DRAMs

Figure 7c illustrates a similar example using the DP8418 to drive two 32-bit banks.





Applications

If one desires a memory interface containing the DP8419 that minimizes the number of external components required, modes 5 and 1 should be used. These two modes provide:

- 1) Automatic access to memory (in mode 5 only one signal, RASIN, is required in order to access memory)
- Hidden refresh capability (refreshes are performed automatically while in mode 5 when non-local accesses are taking place, as determined by CS)
- Refresh request capability (if no hidden refresh took place while RFCK was high, a refresh request is generated at the RFI/O pin when RFCK goes high)
- 4) Automatic forced refresh (If a refresh request is generated while in mode 5, as described above, external logic should switch the DP8419 into mode 1 to do an automatic forced refresh. No other external control signals need be issued. WAIT states can be inserted into the processor machine cycles if the system tries to access memory while the DP8419 is in mode 1 doing a forced refresh.

Some items to be considered when integrating the DP8419 into a system design are:

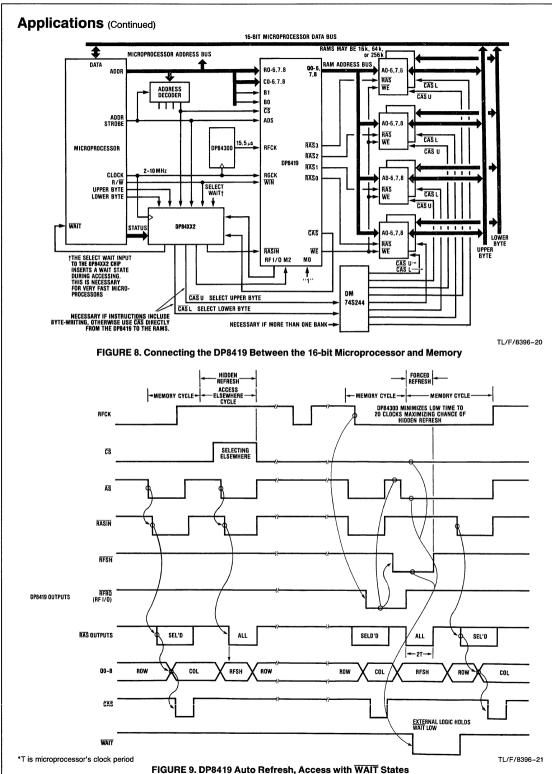
- The system designer should ensure that a DRAM access not be in progress when a refresh mode is entered. Similarly, one should not attempt to start an access while a refresh is in progress. The parameter t_{RFHRL} specifies the minimum time from RFSH high to RASIN going low to initiate an access.
- One should always guarantee that the DP8419 is enabled for access prior to initiating the access (see t_{CSRL1}).
- One should bring RASIN low even during non-local access cycles when in mode 5 in order to maximize the chance of a hidden refresh occurring.
- 4) At lower frequencies (under 10 Mhz), it becomes increasingly important to differentiate between READ and WRITE cycles. RASIN generation during READ cycles can take place as soon as one knows that a processor READ access cycle has started. WRITE cycles, on the other hand, cannot start until one knows that the data to be written at the DRAM inputs will be valid a setup time before CAS (column address strobe) goes true at the DRAM inputs. Therefore, in general, READ cycles can be initiated earlier than WRITE cycles.
- 5) Many times it is possible to only add WAIT states during READ cycles and have no WAIT states during WRITE cycles. This is because it generally takes less time to write data into memory than to read data from memory.

The DP84XX2 family of inexpensive preprogrammed medium Programmable Array Logic devices (PALs) have been developed to provide an easy interface between various

microprocessors and the DP84XX family of DRAM controller/drivers. These PALs interface to all the necessary control signals of the particular processor and the DP8419. The PAL controls the operation of the DP8419 in modes 5 and 1, while meeting all the critical timing considerations discussed above. The refresh clock, RFCK, may be divided down from the processor clock using an IC counter such as the DM74LS393 or the DP84300 programmable refresh timer. The DP84300 can provide RFCK periods ranging from 15.4 µs to 15.6 µs based on an input clock of 2 to 10 MHz. Figure 8 shows a general block diagram for a system using the DP8419 in modes 1 and 5. Figure 9 shows possible timing diagrams for such a system (using WAIT to prohibit access when refreshing). Although the DP84XX2 PALs are offered as standard peripheral devices for the DP84XX DRAM controller/drivers, the programming equations for these devices are provided so the user may make minor modification, for unique system requirements.

ADVANTAGES OF DP8419 OVER A DISCRETE DYNAMIC RAM CONTROLLER

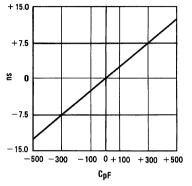
- The DP8419 system solution takes up much less board space because everything is on one chip (latches, refresh counter, control logic, multiplexers, drivers, and internal delay lines).
- 2) Less effort is needed to design a memory system. The DP8419 has automatic modes (1 and 5) which require a minimum of external control logic. Also programmable array logic devices (PALs) have been designed which allow an easy interface to most popular microprocessors (Motorola 68000 family, National Semiconductor 32032 family, Intel 8086 family, and the Zilog Z8000 family).
- 3) Less skew in memory timing parameters because all critical components are on one chip (many discrete drivers specify a minimum on-chip skew under worst-case conditions, but this cannot be used if more then one driver is needed, such as would be the case in driving a large dynamic RAM array).
- 4) Our switching characteristics give the designer the critical timing specifications based on TTL output levels (low = 0.8V, high = 2.4V) at a specified load capacitance. All timing parameters are specified on the DP8419:
 - A) driving 88 DRAM's over a temperature range of 0–70 degrees centigrade (no extra drivers are needed).
 - B) under worst-case driving conditions with all outputs switching simultaneously (most discrete drivers on the market specify worst-case conditions with only one output switching at a time; this is not a true worst-case condition!).



DP8417/NS32817/8418/32818/8419/32819/8419X/32819X

Switching Characteristics

All AC parameters are specified with the equivalent load capacitances, including traces, of 88 DRAMs organized as 4 banks of 22 DRAMs each. Maximums are based on worstcase conditions including all outputs switching simultaneously. This, in many cases, results in the AC values shown in the DP84XX DRAM controller data sheet being much looser than true worst case (maximum) AC delays. The system designer should estimate the DP8419 load in his/her application, and modify the appropriate AC parameters using the graph in *Figure 10*. Two example calculations are provided below.



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FIGURE 10. Change in Propagation Delay Relative to "True" (Application) Load Minus AC Specified Data Sheet Load

2 Examples

#1) A mode 4 user driving 2 16-bit banks of DRAM has the following approximate "true" loading conditions:

CAS - 300 pF

Q0-Q8 - 250 pF

RAS - 150 pF

max t_{RPDL} = 20 ns - 0 ns = 20 ns (since \overline{RAS} loading is the same as that which is spec'ed)

max t_{CPDL} = 32 ns - 7 ns = 25 ns

max t_{CCAS} = 46 ns - 7 ns = 39 ns

max $t_{RCC} = 41 \text{ ns} - 6 \text{ ns} = 35 \text{ ns}$

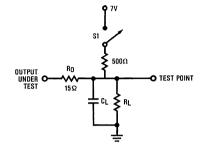
min $t_{\mbox{\scriptsize RHA}}$ is not significantly effected since it does not involve an output transition

Other parameters are adjusted in a similar manner.

 #2) A mode 5 user driving one 16-bit bank of DRAM has the following approximate "true" loading conditions: CAS - 120 pF Q0-Q8 - 100 pF RAS - 120 pF

A. C. parameters should be adjusted as follows:

with RAHS = "1", max t_{RICL} = 70 ns - 11 ns = 59 ns max t_{RCDL} = 55 ns + 1 ns - 11 ns = 45 ns (the + 1 ns is due to lighter RAS loading; the - 11 ns is due to lighter CAS loading) min t_{RAH} = 15 ns + 1 ns = 16 ns The additional 1 ns is due to the fact that the $\overline{\text{PAS}}$ line is driving less (switching faster) than the load to which the 15 ns spec applies. The row address will remain valid for about the same time irregardless of address loading since it is considered to be not valid at the beginning of its transition.





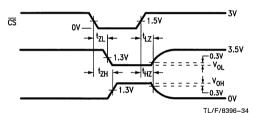


FIGURE 11b. DP8417 TRI-STATE Waveforms

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply voltage, V _{CC}	7.0V
Storage Temperature Range	-65°C to +150°C
Input Voltage	5.5V
Output Current	150 mA
Lead Temp. (Soldering, 10 seconds)	300°C

Operating Conditions

	MIN	мах	Units
Supply Voltage	4.50	5.50	V
Ambient			
Temperature	0	+70	°C
	Ambient	Ambient	Supply Voltage 4.50 5.50 Ambient

Electrical Characteristics $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise	e noted (Note 2)
---	------------------

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _C	Input Clamp Voltage	$V_{CC} = Min, I_C = -12 \text{ mA}$		- 0.8	- 1.2	V
IIH	Input High Current for all Inputs	V _{IN} = 2.5V		2.0	100	μA
I _I RSI	Output Load Current for RFI/O	$V_{IN} = 0.5V$, Output high		-0.7	-1.5	mA
I _{IL1}	Input Low Current for all Inputs**	$V_{IN} = 0.5V$		-0.02	-0.25	mA
I _{IL2}	ADS, R/C, CS, M2, RASIN	$V_{IN} = 0.5V$		-0.05	-0.5	mA
VIL	Input Low Threshold				0.8	V
VIH	Input High Threshold		2.0			V
V _{OL1}	Output Low Voltage*	$I_{OL} = 20 \text{ mA}$		0.3	0.5	V
V _{OL2}	Output Low Voltage for RFI/O	I _{OL} = 8 mA		0.3	0.5	V
V _{OH1}	Output High Voltage*	$I_{OH} = -1 \text{ mA}$	2.4	3.5		V
V _{OH2}	Output High Voltage for RFI/O	I _{OH} = − 100 μA	2.4	3.5		V
I _{1D}	Output High Drive Current*	V _{OUT} = 0.8V (Note 3)	-50	- 200		mA
I _{0D}	Output Low Drive Current*	V _{OUT} = 2.4V (Note 3)	50	200		mA
ICC	Supply Current	V _{CC} = Max		150	240	mA

*Except RFI/O

**Except RFI/O, ADS, R/C, CS, M2, RASIN

Switching Characteristics: DP8417, DP8418, DP8419, DP8419X

 $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5), the output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q8, C_L = 500 pF; $\overline{\text{RAS0}}$ - $\overline{\text{RAS3}}$, C_L = 150 pF; $\overline{\text{WE}}$, C_L = 500 pF; $\overline{\text{CAS}}$, C_L = 600 pF; RL = 500 Ω unless otherwise noted. See *Figure 11a* for test load. S1 is open unless otherwise noted. Maximum propagation delays are specified with all outputs switching.

** Preliminary

Symbol	Parameter	Condition	*(CL	**All C _L	= 50 pF	Units
Symbol	Farameter	Condition	Min	Max	Min	Max	
ACCESS	· · · · · · · · · · · · · · · · · · ·						
t _{RICL0}	$\overline{\text{RASIN}} \text{ to } \overline{\text{CAS}} \text{ Low Delay} \\ (\text{RAHS} = 0)$	<i>Figure 6</i> DP8417, 18, 19-80	57	97	42	85	ns
t _{RICL0}	$\overline{\text{RASIN}} \text{ to } \overline{\text{CAS}} \text{ Low Delay} \\ (\text{RAHS} = 0)$	<i>Figure 6</i> DP8417, 18, 19-70	57	87	42	75	ns
t _{RICL1}	$\frac{\text{RASIN}}{\text{(RAHS}} \text{ to } \overline{\text{CAS}} \text{ Low Delay}$	<i>Figure 6</i> DP8417, 18, 19-80	48	80	35	68	ns
t _{RICL1}	$\overline{\text{RASIN}} \text{ to } \overline{\text{CAS}} \text{ Low Delay} \\ (\text{RAHS} = 1)$	<i>Figure 6</i> DP8417, 18, 19-70	48	70	35	58	ns
t _{RICH}	RASIN to CAS High Delay	Figure 6		37			ns
t _{RCDL0}	$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Low Delay (RAHS = 0)	<i>Figure 6</i> DP8417, 18, 19-80	43	80			ns
t _{RCDL0}	$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Low Delay (RAHS = 0)	<i>Figure 6</i> DP8417, 18, 19-70	43	72			ns
t _{RCDL1}	\overline{RAS} to \overline{CAS} Low Delay (RAHS = 1)	<i>Figure 6</i> DP8417, 18, 19-80	34	63			ns
t _{RCDL1}	$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Low Delay (RAHS = 1)	<i>Figure 6</i> DP8417, 18, 19-70	34	55			ns
t _{RCDH}	RAS to CAS High Delay	Figure 6		22			ns
t _{RAH0}	Row Address Hold Time (RAHS = 0, Mode 5)	Figure 6	25		25		ns
t _{RAH1}	Row Address Hold Time (RAHS = 1, Mode 5)	Figure 6	15		15		ns
tASC	Column Address Set-up Time (Mode 5)	Figure 6	0		0		ns

Switching Characteristics: DP8417, DP8418, DP8419, DP8419X (Continued)

 $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq$ 70°C unless otherwise noted (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q8, $C_L = 500 \text{ pF}$; $\overline{\text{RAS0}} - \overline{\text{RAS3}}$, $C_L = 150 \text{ pF}$; $\overline{\text{WE}}$, $C_L = 500 \text{ pF}$; $\overline{\text{CAS}}$, $C_L = 600 \text{ pF}$; $\text{RL} = 500\Omega$ unless otherwise noted. See *Figure 11a* for test load. S1 is open unless otherwise specified. Maximum propagation delays are specified with all outputs switching.

** Preliminary

Symbol	Parameter	Condition	*CL		**All C _L = 50 pF		Units
-			Min	Max	Min	Max	
ACCESS (C	ontinued)	•					
t _{RCV0}	$\overline{\text{RASIN}} \text{ to Column Address} \\ \text{Valid (RAHS} = 0, \text{ Mode 5)}$	<i>Figure 6</i> DP8417, 18, 19-80		94			ns
t _{RCV0}	$\overrightarrow{RASIN} \text{ to Column Address} \\ \overrightarrow{Valid} (\overrightarrow{RAHS} = 0, \overrightarrow{Mode 5})$	<i>Figure 6</i> DP8417, 18, 19-70		85			ns
t _{RCV1}	$\overrightarrow{\text{RASIN}} \text{ to Column Address} \\ \overrightarrow{\text{Valid}} (\overrightarrow{\text{RAHS}} = 1, \overrightarrow{\text{Mode 5}})$	<i>Figure 6</i> DP8417, 18, 19-80		76			ns
t _{RCV1}	$\overline{\text{RASIN}} \text{ to Column Address} \\ \text{Valid (RAHS} = 1, \text{ Mode 5)}$	<i>Figure 6</i> DP8417, 18, 19-70		68			ns
t _{RPDL}	RASIN to RAS Low Delay	Figures 5a, 5b, 6		21		18	ns
t _{RPDH}	RASIN to RAS High Delay	Figures 5a, 5b, 6		20		17	ns
t _{ASRL}	Address Set-up to RASIN low	Figures 5a, 5b, 6	13				ns
t _{APD}	Address Input to Output Delay	Figures 5a, 5b, 6		36		25	ns
t _{SPD}	Address Strobe High to Address Output Valid	Figures 5a, 5b		48			ns
t _{ASA}	Address Set-up Time to ADS	Figures 5a, 5b, 6	5				ns
t _{AHA}	Address Hold Time from ADS	Figures 5a, 5b, 6	10				ns
t _{ADS}	Address Strobe Pulse Width	Figures 5a, 5b, 6	26				ns
t _{WPD}	WIN to WE Output Delay	Figure 5b		28			ns
^t CPDL	CASIN to CAS Low Delay (R/C low, Mode 4)	Figure 5b	17	33			ns
t _{CPDH}	CASIN to CAS High Delay (R/C low, Mode 4)	Figure 5b	13	33			ns
tCPdif	tCPDL - tCPDH	See Mode 4 Description		13			ns
t _{RCC}	Column Select to Column Address Valid	Figure 5a		41			ns
t _{RCR}	Row Select to Row Address Valid	Figures 5a, 5b		45			ns
t _{RHA}	Row Address Held from Column Select	Figure 5a	7				ns
tCCAS	R/C Low to CAS Low Delay (CASIN Low, Mode 4)	<i>Figure 5a</i> DP8417, 18, 19-80		50			ns
t	R/C Low to CAS Low Delay (CASIN Low, Mode 4)	<i>Figure 5a</i> DP8417, 18, 19-70		46			ns
^t DIF1	Maximum (t _{RPDL} - t _{RHA})	See Mode 4 Description		7			ns
t _{DIF2}	Maximum (t _{RCC} - t _{CPDL})			13			ns
REFRESH	•	· · · · · · · · · · · · · · · · · · ·					•
t _{RC}	Refresh Cycle Period	Figure 2a	100				ns
^t RASINL,H	Pulse Width of RASIN during Refresh	Figure 2a	50				ns
t _{RFPDL0}	RASIN to RAS Low Delay during Refresh (Mode 0)	Figure 2a		28			ns

Switching Characteristics: DP8417, DP8418, DP8419, DP8419X (Continued) $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5). The output load capacitance is typical for 4 banks

of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q8, $C_L = 500 \text{ pF}$; $\overline{RAS0} - \overline{RAS3}$, $C_L = 150 \text{ pF}$; \overline{WE} , $C_L = 500 \text{ pF}$; \overline{CAS} , $C_L = 600 \text{ pF}$; $RL = 500 \Omega$ unless otherwise noted. See *Figure 11a* for test load. S1 is open unless otherwise specified. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Condition	*	CL	All CL :	= 50 pF	Units
Cymbol	r urumeter		Min	Max	Min	Max	
REFRESH	(Continued)		•				
tRFPDL5	RASIN to RAS Low Delay during Hidden Refresh	Figure 7		38			ns
t _{RFPDH0}	RASIN to RAS High Delay during Refresh (Mode 0)	Figure 2a		35			ns
t _{RFPDH5}	RASIN to RAS High Delay during Hidden Refresh	Figure 7		44			ns
^t RFLCT	RFSH Low to Counter Address Valid	<i>Figures 2a, 3</i> TCS = X		38			ns
^t RFLRL	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	Figure 2a	12				ns
t _{RFHRL}	RFSH High Setup to Access RASIN Low	Figure 3	25				ns
^t RFHRV	RFSH High to Row Address Valid	Figure 3		43			ns
^t ROHNC	RAS High to New Count Valid	Figure 2a		42			ns
t _{RST}	Counter Reset Pulse Width	Figure 2a	60				ns
t _{CTL}	RFI/O Low to Counter Outputs All Low	Figure 2a		100			ns
^t RFCKL,H	Minimum Pulse Width of RFCK	Figure 7	100				ns
Т	Period of RAS Generator Clock	Figure 3	30				ns
^t RGCKL	Minimum Pulse Width Low of RGCK	Figure 3	15				ns
^t RGCKH	Minimum Pulse Width High of RGCK	Figure 3	15				ns
tFRQL	RFCK Low to Forced RFRQ (RFI/O) Low	<i>Figure 3</i> C _L = 50 pF RL = 35k		66			ns
t _{FRQH}	RGCK Low to Forced RFRQ High	<i>Figure 3</i> C _L = 50 pF RL = 35k		55			ns
t _{RGRL}	RGCK Low to RAS Low	Figure 3	20	41			ns
tRGRH	RGCK Low to RAS High	Figure 3	20	48			ns

Switching Characteristics: DP8417, DP8418, DP8419, DP8419X (Continued)

 $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq$ 70°C unless otherwise noted (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q8, $C_L = 500 \text{ pF}$; $\overline{RAS0} - \overline{RAS3}$, $C_L = 150 \text{ pF}$; \overline{WE} , $C_L = 500 \text{ pF}$; \overline{CAS} , $C_L = 600 \text{ pF}$; $RL = 500\Omega$ unless otherwise noted. See *Figure 11a* for test load. S1 is open unless otherwise specified. Maximum propagation delays are specified with all outputs switching.

Symbol	Parameter	Parameter Condition		CL	$AII C_L = 50 pF$		Units
eyniber	, arameter	Condition	Min	Max	Min	Max	
REFRESH	(Continued)						
t _{RQHRF}	RFSH Hold Time from RGCK	Figure 3	2T				ns
t _{RFRH}	RFSH High to RAS High (Ending Forced Refresh early)	(See Mode 1 Description)		42			ns
^t RFSRG	RFSH Low Set-up to RGCK Low (Mode 1)	(See Mode 1 Description) <i>Figure 3</i>	12				ns
^t CSHR	CS High to RASIN Low for Hidden Refresh	Figure 7	10				ns
^t rkrl	RFCK High to RASIN low for hidden Refresh		50				ns
DP8419, D	P8419X ONLY						
t _{CSRL1}	CS Low to Access RASIN Low (Using Mode 5 with Auto Refresh Mode)	Figure 3	34				ns
t _{CSRL0}	CS Low to Access RASIN Low (Using Modes 4 or 5 with externally controlled Refresh)	(See Mode 5 Description)	5				ns
DP8418 O	NLY						
tCSRL1	CS Low to Access RASIN Low (Using Mode 5 with Auto Refresh Mode)	Figure 3	5				ns
tCSRL0	CS Low to Access RASIN Low (Using Modes 4 or 5 with externally controlled Refresh)	(See Mode 5 Description)	5				ns
DP8417 O	NLY — PRELIMINARY					·•	
^t CSRL1	CS Low to Access RASIN Low (Using Mode 5 with Auto Refresh Mode)	Figure 3	34				ns
tCSRL0	CS Low to Access RASIN Low (Using Modes 4 or 5 with externally controlled Refresh)	(See Mode 5 Description)	34				ns
TRI-STAT	E (DP8417 ONLY)	· · · · · · · · · · · · · · · · · · ·					
^t zн	CS Low to Output High from Hi-Z	S1 Open Figure 11b		50			ns
tнz	CS High to Output Hi-Z from High	S1 Open, Q, WE <i>Figure 11b</i>				50	ns
ţнz	CS High to Output Hi-Z from High	S1 Open, RAS0-3 CAS0-3 <i>Figure 11b</i>				95	ns
t _{ZL}	CS Low to Output Low from Hi-Z	S1 Closed Figure 11b		50			ns
t _{LZ}	CS High to Output Hi-Z from Low	S1 Closed Figure 11b				50	ns

Input Capacitance T _A = 25°C (Note 2)						
Symbol	Parameter	Condition	Min	Тур	Max	Units
C _{IN}	Input Capacitance ADS, R/C, CS, M2, RASIN			8		pF
CIN	Input Capacitance All Other Inputs			5		pF

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: All typical values are for $T_A = 25^{\circ}C$ and $V_{CC} = 5.0V$.

Note 3: This test is provided as a monitor of Driver output source and sink current capability. Caution should be exercised in testing this parameter. In testing these parameters, a 15Ω resistor should be placed in series with each output under test. One output should be tested at a time and test time should not exceed 1 second. Note 4: Input pulse 0V to 3.0V, $t_R = t_F = 2.5$ ns, f = 2.5 MHz, $t_{PW} = 200$ ns. Input reference point on AC measurements is 1.5V Output reference points are 2.4V for High and 0.8V for Low.

Note 5: The load capacitance on RF I/O should not exceed 50 pF.



DP8428/NS32828, DP8429/NS32829 1 Megabit High Speed Dynamic RAM Controller/Drivers

General Description

The DP8428 and DP8429 1M DRAM Controller/Drivers are designed to provide "No-Waitstate" CPU interface to Dynamic RAM arrays of up to 8 Mbytes and larger. The DP8428 and DP8429 are tailored for 32-bit and 16-bit system requirements, respectively. Both devices are fabricated using National's new oxide isolated Advanced Low power Schottky (ALS) process and use design techniques which enable them to significantly out-perform all other LSI or discrete alternatives in speed, level of integration, and power consumption.

Each device integrates the following critical 1M DRAM controller functions on a single monolithic device: ultra precise delay line; 9 bit refresh counter; fall-through row, column, and bank select input latches; Row/Column address muxing logic; on-board high capacitive-load RAS, CAS, Write Enable and Address output drivers; and, precise control signal timing for all the above.

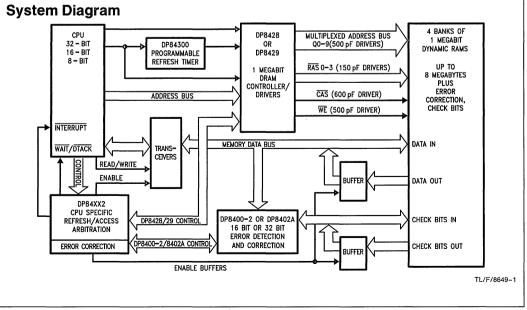
In order to specify each device for "true" worst case operating conditions, all timing parameters are guaranteed while the chip is driving the capacitive load of 88 DRAMs including trace capacitance. The chip's delay timing logic makes use of a patented new delay line technique which keeps AC skew to ± 3 ns over the full V_{CC} range of $\pm 10\%$ and temperature range of -55° C to $\pm 125^{\circ}$ C. The DP8428 and DP8429 guarantee a maximum RASIN to CASOUT delay of 80 ns or 70 ns even while driving an 8 Mbyte memory array with error correction check bits included. Two speed selecting characteristics section of this document. (Continued)

Features

- Makes DRAM interface and refresh tasks appear virtually transparent to the CPU making DRAMs as easy to use as static RAMs
- Specifically designed to eliminate CPU wait states up to 10 MHz or beyond
- Eliminates 20 discrete components for significant board real estate reduction, system power savings and the elimination of chip-to-chip AC skewing
- On-board ultra precise delay line
- On-board high capacitive RAS, CAS, WE and Address drivers (specified driving 88 DRAMs directly)
- AC specified for directly addressing up to 8 Mbytes
- Low power/high speed bipolar oxide isolated process
- Downward pin and function compatible with 256k DRAM Controller/Drivers DP8409A, DP8417, DP8418, and DP8419

Contents

- System and Device Block Diagrams
- Recommended Companion Components
- Device Connection Diagrams and Pin Definitions
- Device Differences-DP8428 vs DP8429
- Mode of Operation (Descriptions and Timing Diagrams)
- D Application Description and Diagrams
- DC/AC Electrical Specifications, Timing Diagrams and Test Conditions



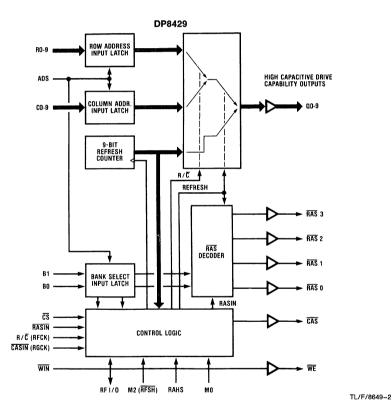
General Description (Continued)

With its four independent AS outputs and ten multiplexed address outputs, the DP8429 can support up to four banks of 64k, 256k or 1M DRAMs. Two bank select pins, B1 and B0, are decoded to activate one of the AS signals during an access, leaving the three non-selected banks in the standby mode (less than one tenth of the operating power) with data outputs in TRI-STATE®. The DP8428's one Bank Select pin, B1, enables 2 banks automatically during an access in order to provide an optimum interface for 32-bit microprocessors.

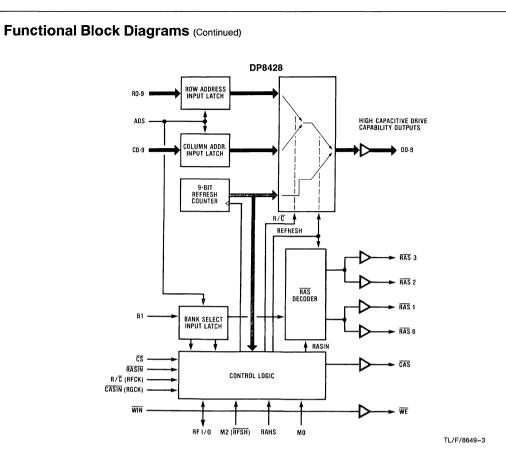
The DP8428 and DP8429 each have two mode-select pins, allowing for two refresh modes and two access modes. Refresh and access timing may be controlled either externally or automatically. The automatic modes require a minimum of input control signals.

A refresh counter is on-chip and is multiplexed with the row and column inputs. Its contents appear at the address outputs of the DP8428 or DP8429 during any refresh, and are incremented at the completion of the refresh. Row, Column and bank address latches are also on-chip. However, if the address inputs to the DP8428 or DP8429 are valid throughout the duration of the access, these latches may be operated in the fall-through mode.

Each device is available in either the 52 pin Ceramic DIP, or the low cost JEDEC standard 68 pin Plastic Chip Carrier (PCC) package.

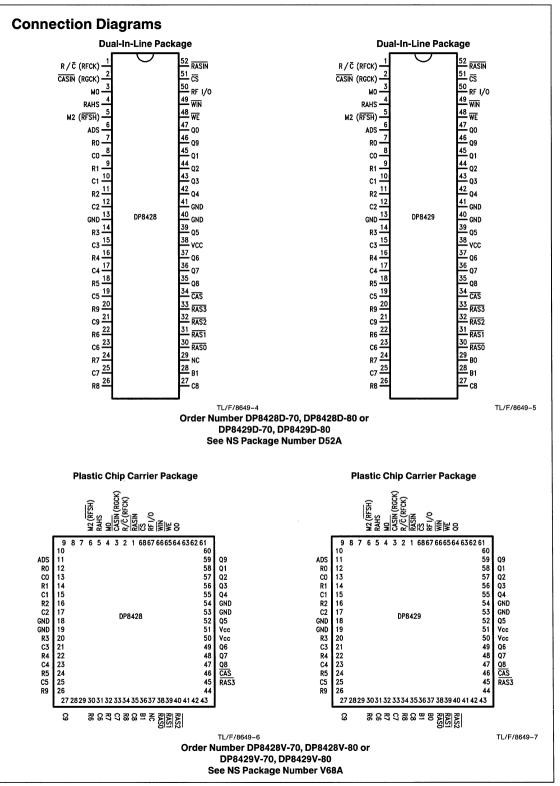


Functional Block Diagrams



System Companion Components

Device #	Function
DP84300	Programmable Refresh Timer for DP84xx DRAM Controller
DP84412	NS32008/16/32 to DP8409A/17/18/19/28/29 Interface
DP84512	NS32332 to DP8417/18/19/28/29 Interface
DP84322	68000/08/10 to DP8409A/17/18/19/28/29 Interface (up to 8 MHz)
DP84422	68000/08/10 to DP8409A/17/18/19/28/29 Interface (up to 12.5 MHz)
DP84522	68020 to DP8417/18/19/28/29 Interface
DP84432	8086/88/186/188 to DP8409A/17/18/19/28/29 Interface
DP84532	80286 to DP8409A/17/18/19/28/29 Interface
DP8400-2	16-Bit Expandable Error Checker/Corrector (E2C2)
DP8402A	32-Bit Error Detector And Corrector (EDAC)



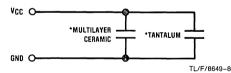
DP8428 vs DP8429

The DP8428 DYNAMIC RAM CONTROLLER/DRIVER is identical to the DP8429 with the exception of two functional differences incorporated to improve performance with 32-bit microprocessors.

- 1) Pin 28 (B1) is used to enable/disable a pair of RAS outputs, and pin 29 (B0 on the DP8429) is a no connect. When B1 is low, RAS0 and RAS1 are enabled such that they both go low during an access. When B1 is high, RAS2 and RAS3 are enabled. This feature is useful when driving words of 32 bits or more since each RAS would be driving only one half of the word. By distributing the load on each RAS line in this way, the DP8428 will meet the same AC specifications driving 4 banks of 16 bits each.
- 2) The hidden refresh function available on the DP8429 has been disabled on the DP8428 in order to reduce the amount of setup time necessary from CS going low to RASIN going low during an access of DRAM. This parameter, called t_{CSRL1}, is 5 ns for the DP8428 whereas it is 34 ns for the DP8429. The hidden refresh function allowed only a very small increase in system performance, at microprocessor frequencies of 10 MHz and above.

Pin Definitions

 V_{CC} , GND, GND – V_{CC} = 5V \pm 10%. The three supply pins have been assigned to the center of the package to reduce voltage drops, both DC and AC. There are two ground pins to reduce the low level noise. The second ground pin is located two pins from V_{CC} , so that decoupling capacitors can be inserted directly next to these pins. It is important to adequately decouple this device, due to the high switching currents that will occur when all 10 address bits change in the same direction simultaneously. A recommended solution would be a 1 μ F multilayer ceramic capacitor in parallel with a low-voltage tantalum capacitor, both connected as close as possible to GND and V_{CC} to reduce lead inductance. See Figure below.



*Capacitor values should be chosen depending on the particular application.

R0-R9: Row Address Inputs.

C0-C9: Column Address Inputs.

Q0-Q9: Multiplexed Address Outputs - This address is selected from the Row Address Input Latch, the Column Address Input Latch or the Refresh Counter.

RASIN: Row Address Strobe Input – RASIN directly controls the selected RAS output when in an access mode and all RAS outputs during hidden or external refresh.

 $\mathbf{R}/\overline{\mathbf{C}}$ (**RFCK**) – In the auto-modes this pin is the external refresh clock input; one refresh cycle should be performed each clock period. In the external access mode it is Row/ Column Select Input which enables either the row or column address input latch onto the output bus.

CASIN (RGCK) – In the auto-modes this pin is the RAS Generator Clock input. In external access mode it is the Column Address Strobe input which controls CAS directly once columns are enabled on the address outputs.

ADS: Address (Latch) Strobe Input – Row Address, Column Address, and Bank Select Latches are fall-through with ADS high; latching occurs on high-to-low transition of ADS.

 $\overline{\text{CS:}}$ Chip Select Input – When high, $\overline{\text{CS}}$ disables all accesses. Refreshing, however, in both modes 0 and 1 is not affected by this pin.

M0, M2 (RFSH): Mode Control Inputs – These pins select one of the four available operational modes of the DP8429 (see Table III).

RFI/0: Refresh Input/Output – In the auto-modes this pin is the Refresh Request Output. It goes low following RFCK indicating that no hidden refresh was performed while RFCK was high. When this pin is set low by an external gate the on-chip refresh counter is reset to all zeroes.

WIN: Write Enable Input.

WE: Write Enable Output - WE follows WIN unconditionally.

RAHS: Row Address Hold Time Select – Selects the t_{RAH} to be guaranteed by the DP8428 or DP8429 delay line to allow for the use of fast or slow DRAMs.

CAS: Column Address Strobe Output – In mode 5 and in mode 4 with CASIN low before R/C goes low, CAS goes low automatically after the column address is valid on the address outputs. In mode 4 CAS follows CASIN directly after R/C goes low, allowing for nibble accessing. CAS is always high during refresh.

RAS 0-3: Row Address Strobe Outputs – The enabled RAS output (see Table II) follows RASIN directly during an access. During refresh, all RAS outputs are enabled.

Pin Definitions (Continued)

B0, B1: Bank Select Inputs – These pins are decoded to enable one or two of the four $\overrightarrow{\text{RAS}}$ outputs during an access (see Table I and Table II).

	Select d by ADS)	Enabled RAS _n
B1	B0	
0	0	RAS ₀
0	1	RAS
1	0	RAS ₂
1	1	RAS ₃

TABLE I. DP8429 Memory Bank Decode

TABLE II. DP8428 Memory Bank Decode

	Select by ADS)	Enabled RAS _n
B1	NC	
0	X	RAS ₀ & RAS ₁
1	X	RAS ₂ & RAS ₃

Conditions for All Modes

INPUT ADDRESSING

The address block consists of a row-address latch, a column-address latch, and a resettable refresh counter. The address latches are fall-through when ADS is high and latch when ADS goes low. If the address bus contains valid addresses until after CAS goes low at the end of the memory cycle, ADS can be permanently high. Otherwise ADS must go low while the addresses are still valid.

DRIVE CAPABILITY

The DP8429 has timing parameters that are specified driving the typical capacitance (including traces) of 88, 5V-only DRAMs. Since there are 4 $\overrightarrow{\text{RAS}}$ outputs, each is specified driving one-fourth of the total memory. $\overrightarrow{\text{CAS}}$, $\overrightarrow{\text{WE}}$ and the address outputs are specified driving all 88 DRAMs.

The graph in *Figure 10* may be used to determine the slight variations in timing parameters, due to loading conditions other than 88 DRAMs.

Because of distributed trace capacitance and inductance and DRAM input capacitance, current spikes can be created, causing overshoots and undershoots at the DRAM inputs that can change the contents of the DRAMs or even destroy them. To reduce these spikes, a damping resistor (low inductance, carbon) should be inserted between the DP8429 outputs and the DRAMs, as close as possible to the DP8429. The damping resistor values may differ depending on how heavily an output is loaded. These resistors should be determined by the first prototypes (not wire-wrapped due to the larger distributed capacitance and inductance). Resistors should be chosen such that the transition on the control outputs is critically damped. Typical values will be from 15Ω to 100Ω , with the lower values being used with the larger memory arrays. Note that AC parameters are specified with 15Ω damping resistors. For more information see AN-305 "Precautions to Take When Driving Memories".

DP8429 DRIVING ANY 256k or 1M DRAMS

The DP8429 can drive any 256k or 1M DRAMs. 256k DRAMs require 18 of the DP8429's address inputs to select one memory location within the DRAM. RAS-only refreshing with the nine-bit refresh-counter on the DP8429 makes CAS before RAS refreshing, available on 256k DRAMs, unnecessary (see *Figure 1a*).

1 Mbit DRAMs require the use of all 10 of the DP8429 Address Outputs (see *Figure 1b*).

READ, WRITE AND READ-MODIFY-WRITE CYCLES

The output signal, \overline{WE} , determines what type of memory access cycle the memory will perform. If \overline{WE} is kept high while \overline{CAS} goes low, a read cycle occurs. If \overline{WE} goes low before \overline{CAS} goes low, a write cycle occurs and data at DI (DRAM input data) is written into the DRAM as \overline{CAS} goes low later than t_{CWD} after \overline{CAS} goes low, first a read occurs and DO (DRAM output data) becomes valid, then data DI is written into the same address in the DRAM as \overline{WE} goes low. In this read-modify-write case, DI and DO cannot be linked together. \overline{WE} always follows WIN directly to determine the type of access to be performed.

POWER-UP INITIALIZE

When V_{CC} is first applied to the DP8429, an initialize pulse clears the refresh counter and the internal control flip-flops.

Mode Features Summary

- 4 modes of operation: 2 access and 2 refresh
- Automatic or external selected by the user
- Auto access mode provides RAS, row to column change, and then CAS automatically.
- Choice between two different values of t_{RAH} in auto-access mode
- CAS controlled independently in external control mode, allowing for nibble mode accessing
- Automatic refreshing can make refreshes transparent to the system
- CAS is inhibited during refresh cycles

DP8428/DP8429 Mode Descriptions

MODE 0-EXTERNALLY CONTROLLED REFRESH

Figure 2 shows the Externally Controlled Refresh timing. In this mode the refresh counter contents are multiplexed to the address outputs. All $\overline{\text{RAS}}$ outputs are enabled to follow RASIN so that the row address indicated by the refresh counter is refreshed in all DRAM banks when $\overline{\text{RASIN}}$ goes low. The refresh counter increments when $\overline{\text{RASIN}}$ goes high. $\overline{\text{RFSH}}$ should be held low at least until $\overline{\text{RASIN}}$ goes high (they may go high simultaneously) so that the refresh address remains valid and all $\overline{\text{RAS}}$ outputs remain enabled throughout the refresh.

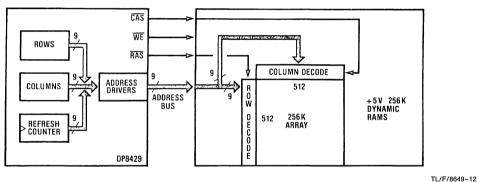
A burst refresh may be performed by holding $\overline{\text{RFSH}}$ low and toggling $\overline{\text{RASIN}}$ until all rows are refreshed. It may be useful in this case to reset the refresh counter just prior to beginning the refresh. The refresh counter resets to all zeroes when RFI/O is pulled low by an external gate. The refresh counter always counts to 511 before rolling over to zero. If there are 128 or 256 rows being refreshed then Q7 or Q8, respectively, going high may be used as an end-of-burst indicator.

In order that the refresh address is valid on the address outputs prior to the RAS lines going low, RFSH must go low before RASIN. The setup time required is given by $t_{\rm RFLRL}$ in the Switching Characteristics. This parameter may be adjusted using *Figure 10* for loading conditions other than those specified.

TABLE III. DP8428/DP8429 Mode Select Options

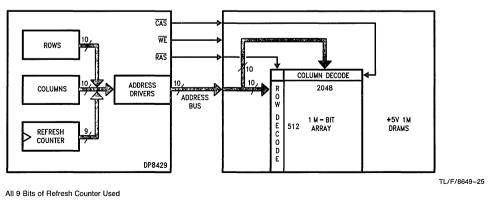
Mode	(RFSH) M2	мо	Mode of Operation
0	0	0	Externally Controlled Refresh
1	0	1	Auto Refresh-Forced
4	1	0	Externally Controlled Access
5	1	1	Auto Access (Hidden Refresh)

DP8428/DP8429 Interface Between System and DRAM Banks



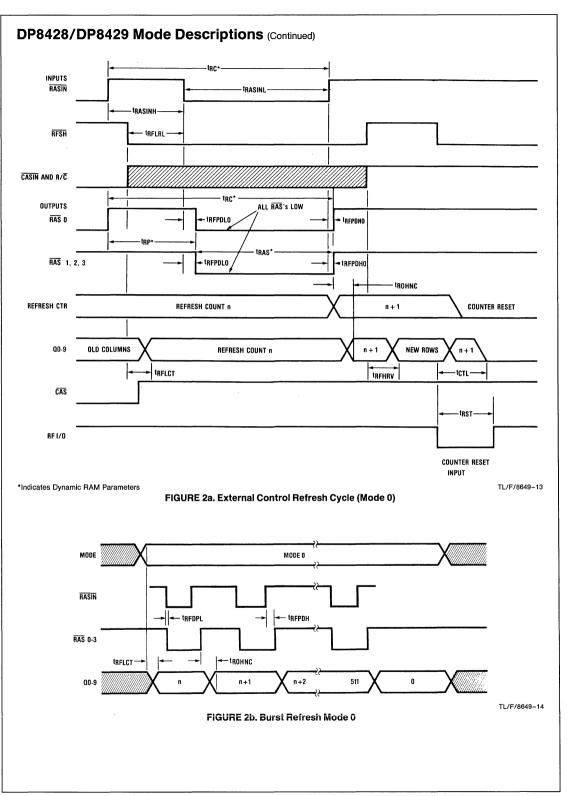
All 9 Bits of Refresh Counter Used

FIGURE 1a. DP8428/DP8429 with 256k DRAMs









DP8428/DP8429 Mode Descriptions (Continued)

MODE 1-AUTOMATIC FORCED REFRESH

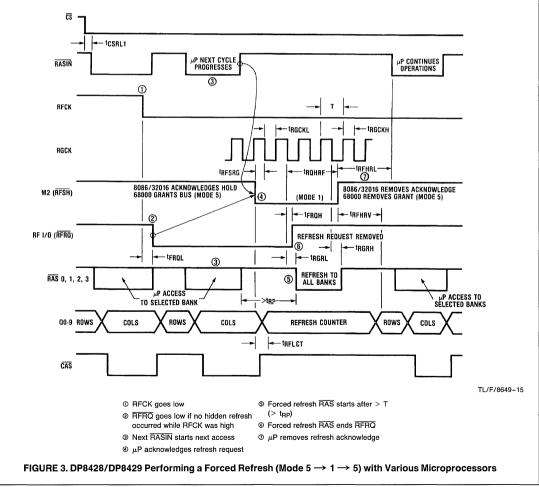
In Mode 1 the R/\overline{C} (RFCK) pin becomes RFCK (refresh cycle clock) and the \overline{CASIN} (RGCK) pin becomes RGCK (RAS generator clock). If RFCK is high and Mode 1 is entered then the chip operates as if in MODE 0 (externally controlled refresh), with all RAS outputs following RASIN. This feature of Mode 1 may be useful for those who want to use Mode 5 (automatic access) with externally controlled refresh. By holding RFCK permanently high one need only toggle M2 (RFSH) to switch from Mode 5 to external refresh. As with Mode 0, RFI/O may be pulled low by an external gate to reset the refresh counter.

When using Mode 1 as automatic refresh, RFCK must be an input clock signal. One refresh should occur each period of RFCK. If no refresh is performed while RFCK is high, then when RFCK goes low RFI/O immediately goes low to indicate that a refresh is requested. (RFI/O may still be used to reset the refresh counter even though it is also used as a refresh request pin, however, an open-collector gate should be used to reset the counter in this case since RFI/O is forced low internally for a request).

After receiving the refresh request the system must allow a forced refresh to take place while RFCK is low. External logic can monitor $\overline{\text{RFRQ}}$ (RFI/O) so that when $\overline{\text{RFRQ}}$ goes low this logic will wait for the access currently in progress to be completed before pulling M2 (RFSH) low to put the DP8429 in mode 1. If no access is taking place when $\overline{\text{RFRQ}}$ occurs, then M2 may immediately go low. Once M2 is low, the refresh counter contents appear at the address outputs and $\overline{\text{RAS}}$ is generated to perform the refresh.

An external clock on RGCK is required to derive the refresh $\overline{\text{RAS}}$ signals. On the second falling edge of RGCK after M2 is low, all $\overline{\text{RAS}}$ lines go low. They remain low until two more falling edges of RGCK. Thus $\overline{\text{RAS}}$ remains high for one to two periods of RGCK after M2 goes low, and stays low for two periods. In order to obtain the minimum delay from M2 going low to $\overline{\text{RAS}}$ going low, M2 should go low t_{RFSRG} before the falling edge of RGCK.

The Refresh Request on RFI/O is terminated as RAS goes low. This signal may be used to end the refresh earlier than it normally would as described above. If M2 is pulled high



DP8428/DP8429/NS32828/NS32829

DP8428/DP8429 Mode Descriptions (Continued)

while the \overline{RAS} lines are low, then the \overline{RASs} go high t_{RFRH} later. The designer must be careful, however, not to violate the minimum \overline{RAS} low time of the DRAMs. He must also guarantee that the minimum \overline{RAS} precharge time is not violated during a transition from mode 1 to mode 5 when an access is desired immediately following a refresh.

If the processor tries to access memory while the DP8429 is in mode 1, WAIT states should be inserted into the processor cycles until the DP8429 is back in mode 5 and the desired access has been accomplished (see *Figure 9*).

Instead of using WAIT states to delay accesses when refreshing, HOLD states could be used as follows. $\overrightarrow{\text{RFRQ}}$ could be connected to a HOLD or Bus Request input to the system. When convenient, the system acknowledges the HOLD or Bus Request by pulling M2 low. Using this scheme, HOLD will end as the RAS lines go low (RFI/O goes high). Thus, there must be sufficient delay from the time HOLD goes high to the DP8429 returning to mode 5, so that the RAS low time of the DRAMs isn't violated as described earlier (see *Figure 3* for mode 1 refresh with Hold states).

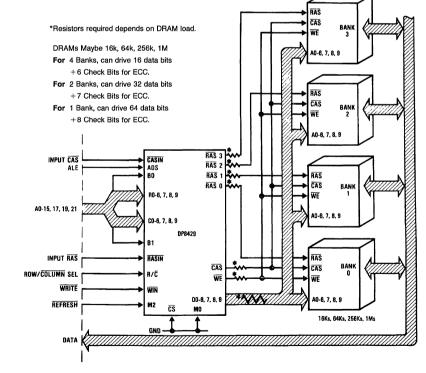
To perform a forced refresh the system will be inactive for about four periods of RGCK. For a frequency of 10 MHz, this is 400 ns. To refresh 128 rows every 2 ms an average of about one refresh per 16 μ s is required. With a RFCK period of 16 μ s and RGCK period of 100 ns, DRAM accesses are delayed due to refresh only 2.5% of the time. If using the Hidden Refresh available in mode 5 (refreshing with RFCK high) this percentage will be even lower.

MODE 4 - EXTERNALLY CONTROLLED ACCESS

In this mode all control signal outputs can be controlled directly by the corresponding control input. The enabled RAS output follows RASIN, CAS follows CASIN (with R/C low), WE follows \overline{WIN} and R/C determines whether the row or the column inputs are enabled to the address outputs (see *Figure 4*).

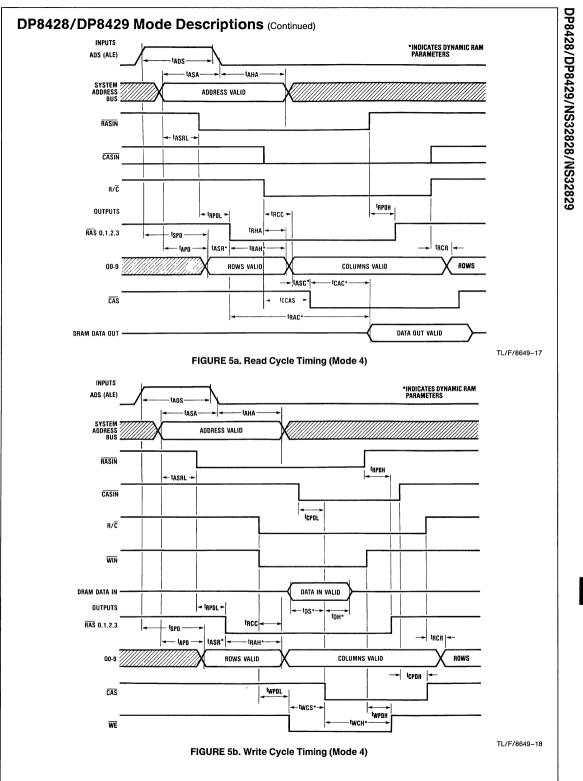
With R/ \overline{C} high, the row address latch contents are enabled onto the address bus. $\overline{\text{RAS}}$ going low strobes the row address into the DRAMs. After waiting to allow for sufficient row-address hold time (t_{RAH}) after RAS goes low, R/ \overline{C} can go low to enable the column address latch contents onto the address bus. When the column address is valid, \overline{CAS} going low will strobe it into the DRAMs. WiN determines whether the cycle is a read, write or read-modify-write access. Refer to *Figures 5a* and *5b* for typical Read and Write timing using mode 4.

Page or Nibble mode may be performed by toggling CASIN once the initial access has been completed. In the case of page mode the column address must be changed before



TL/F/8649-16





DP8428/DP8429 Mode Descriptions (Continued)

 $\overline{\text{CASIN}}$ goes low to access a new memory location (see *Figure 5c*). Parameter t_{CPdif} has been specified in order that users may easily determine minimum $\overline{\text{CAS}}$ pulse widths when $\overline{\text{CASIN}}$ is toggling.

AUTOMATIC CAS GENERATION

 $\label{eq:response} \begin{array}{l} \hline CAS \mbox{ is held high when } R/C \mbox{ is high even if } \hline CASIN \mbox{ is low. If } \\ \hline CASIN \mbox{ is low when } R/C \mbox{ goes low, } \hline CAS \mbox{ goes low automatically, } \\ t_{ASC} \mbox{ after the column address is valid. This feature eliminates the need for an externally derived } \hline CASIN \mbox{ signal to control } \hline CAS \mbox{ when performing a simple access } (Figure 5a \mbox{ demonstrates Auto-} \hline CAS \mbox{ generation in mode } 4). Page or nible accessing may be performed as shown in Figure 5c \mbox{ even if } \hline CAS \mbox{ is generated automatically for the initial access.} \end{array}$

FASTEST MEMORY ACCESS

The fastest Mode 4 access is achieved by using the automatic \overline{CAS} feature and external delay line to generate the required delay between \overline{RASIN} and R/C. The amount of delay required depends on the minimum t_{RAH} of the DRAMs being used. The DP8429 parameter t_{DIF1} has been specified in order that the delay between \overline{RASIN} and R/\overline{C} may be minimized.

t_{DIF1} = MAXIMUM (t_{BPDL} - t_{BHA})

where $t_{RPDL} = \overline{RASIN}$ to \overline{RAS} delay

and $t_{RHA} =$ row address held from R/\overline{C} going low.

The delay between $\overline{\text{RASIN}}$ and R/\overline{C} that guarantees the specified DRAM t_{RAH} is given by

MINIMUM **RASIN** to $R/\overline{C} = t_{DIF1} + t_{RAH}$.

Example

In an application using DRAMs that require a minimum t_{RAH} of 15 ns, the following demonstrates how the maximum $\overline{\text{RASIN}}$ to $\overline{\text{CAS}}$ time is determined.

With t_{DIF1} (from Switching Characteristics) = 7 ns,

 $\overline{\text{RASIN}}$ to $\overline{\text{R/C}}$ delay = 7 ns + 15 ns = 22 ns.

A delay line of 25 ns will be sufficient.

With Auto- \overline{CAS} generation, the maximum delay from R/\overline{C} to \overline{CAS} (loaded with 600 pF) is 46 ns. Thus the maximum \overline{RASIN} to \overline{CAS} time is 71 ns, under the given conditions.

With a maximum $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ time (t_{RPDL}) of 20 ns, the maximum $\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ time is about 51 ns. Most DRAMs with a 15 ns minimum t_{RAH} have a maximum t_{RCD} of about 60 ns. Thus memory accesses are likely to be $\overline{\text{RAS}}$ limited instead of $\overline{\text{CAS}}$ limited. In other words, memory access time is limited by DRAM performance, not controller performance.

REFRESHING IN CONJUNCTION WITH MODE 4

If using mode 4 to access memory, mode 0 (externally controlled refresh) must be used for all refreshing.

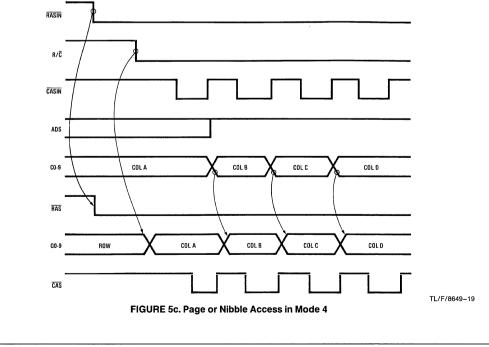
MODE 5 – AUTOMATIC ACCESS WITH HIDDEN RE-FRESHING CAPABILITY

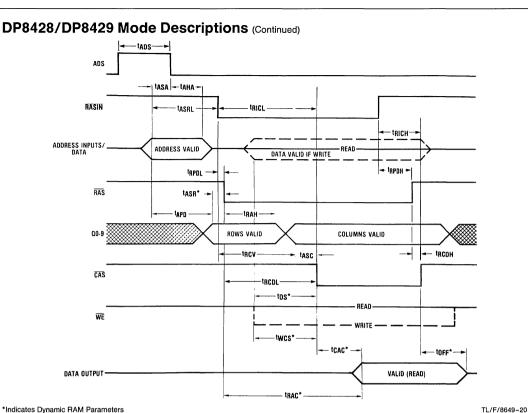
Automatic-Access has two advantages over the externally controlled access (mode 4). First, RAS, CAS and the row to column change are all derived internally from one input signal, RASIN. Thus the need for an external delay line (see mode 4) is eliminated.

Secondly, since R/C and \overline{CASIN} are not needed to generate the row to column change and \overline{CAS} , these pins can be used for the automatic refreshing function.

AUTOMATIC ACCESS CONTROL

Mode 5 of the DP8429 makes accessing Dynamic RAM nearly as easy as accessing static RAM. Once row and column addresses are valid (latched on the DP8429 if necessary), $\overrightarrow{\text{RASIN}}$ going low is all that is required to perform the memory access.



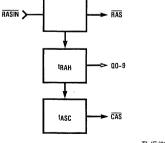


*Indicates Dynamic RAM Parameters

FIGURE 6. Mode 5 Timing

(Refer to Figure 6) In mode 5 the selected RAS follows RASIN immediately, as in mode 4, to strobe the row address into the DRAMs. The row address remains valid on the DP8429 address outputs long enough to meet the t_{BAH} requirement of the DRAMs (pin 4, RAHS, of the DP8429 allows the user two choices of tRAH). Next, the column address replaces the row address on the address outputs and CAS goes low to strobe the columns into the DRAMs. WIN determines whether a read, write or read-modify-write is done.

The diagram below illustrates mode 5 automatic control signal generation.



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REFRESHING IN CONJUNCTION WITH MODE 5

When using mode 5 to perform memory accesses, refreshing may be accomplished:

(a) externally (in mode 0 or mode 1)

- (b) by a combination of mode 5 (hidden refresh) and mode 1 (auto-refresh)
- by a combination of mode 5 and mode 0 or (c)

(a) Externally Controlled Refreshing in Mode 0 or Mode 1

All refreshing may be accomplished using external refreshes in either mode 0 or mode 1 with R/C (RFCK) tied high (see mode 0 and mode 1 descriptions). If this is desired, the system determines when a refresh will be performed, puts the DP8429 in the appropriate mode, and controls the RAS signals directly with RASIN. The on-chip refresh counter is enabled to the address outputs of the DP8429 when the refresh mode is entered, and increments when RASIN goes high at the completion of the refresh.

(b) Mode 5 Refreshing (hidden) with Mode 1 refreshing (auto)

(Refer to Figure 7a) If RFCK is tied to a clock (see mode 1 description), RFI/O becomes a refresh request output and goes low following RFCK going low if no refresh occurred while RFCK was high. Refreshes may be performed in mode 5 when the DP8429 is not selected for access (CS is high) and RFCK is high. If these conditions exist the refresh counter contents appear on the DP8429 address outputs and all RAS lines follow RASIN so that if RASIN goes low (an access other than through the DP8429 occurs), all RAS lines go low to perform the refresh. The DP8429 allows only one refresh of this type for each period of RFCK, since RFCK should be fast enough such that one refresh per period is sufficient to meet the DRAM refresh requirement.

DP8428/DP8429 Mode Descriptions (Continued)

Once it is started, a hidden refresh will continue even if RFCK goes low. However, $\overline{\text{CS}}$ must be high throughout the refresh (until $\overline{\text{RASIN}}$ goes high).

These hidden refreshes are valuable in that they do not delay accesses. When determining the duty cycle of RFCK, the high time should be maximized in order to maximize the probability of hidden refreshes. If a hidden refresh doesn't happen, then a refresh request will occur on RFI/O when RFCK goes low. After receiving the request, the system must perform a refresh while RFCK is low. This may be done by going to mode 1 and allowing an automatic refresh (see mode 1 description). This refresh must be completed while RFCK is low, thus the RFCK low time is determined by the worst-case time required by the system to respond to a refresh request.

(c) Mode 5 Refresh (Hidden Refresh) with mode 0 Refresh (External Refresh)

This refresh scheme is identical to that in (b) except that after receiving a refresh request, mode 0 is entered to do the refresh (see mode 0 description). The refresh request is terminated (RFI/O goes high) as soon as mode 0 is entered. This method requires more control than using mode 1 (auto-refresh), however, it may be desirable if the mode 1 refresh time is considered to be excessive.

Example

Figure 7b demonstrates how a system designer would use the DP8429 in mode 5 based on certain characteristics of his system.

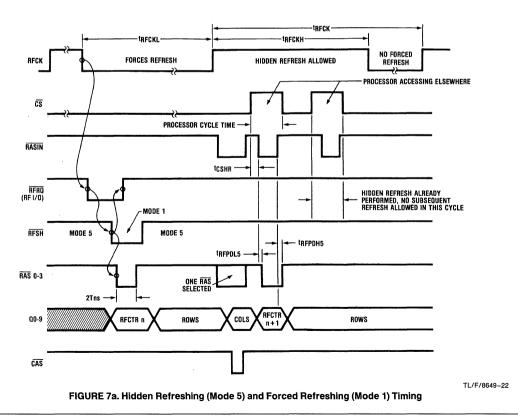
System Characteristics:

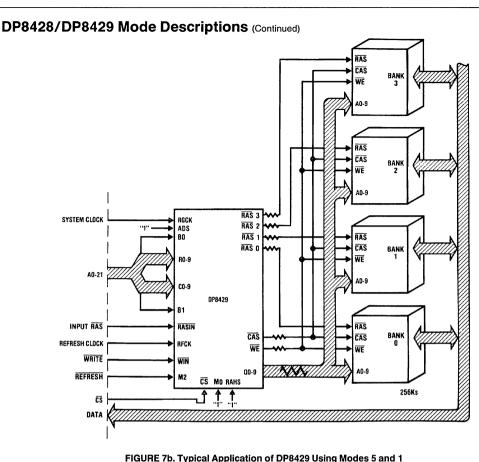
- 1) DRAM used has min $t_{\hbox{\scriptsize RAH}}$ requirement of 15 ns and min $t_{\hbox{\scriptsize ASR}}$ of 0 ns
- 2) DRAM address is valid from time T_V to the end of the memory cycle
- 3) four banks of twenty-two 256k memory chips each are being driven

Using the DP8429 (see Figure 7b):

- 1) Tie pin 4 (RAHS) high to guarantee a 15 ns minimum t_{RAH} which is sufficient for the DRAMs being used
- 2) Generate RASIN no earlier than time $T_V + t_{ASRL}$ (see switching characteristics), so that the row address is valid on the DRAM address inputs before RAS occurs
- 3) Tie ADS high since latching the DRAM address on the DP8429 is not necessary
- 4) Connect the first 20 system address bits to R0-R9 and C0-C9, and bits 21 and 22 to B0 and B1
- 5) Connect each RAS output of the DP8429 to the RAS inputs of the DRAMs of one bank of the memory array; connect Q0-Q9 of the DP8429 to A0-A9 of all DRAMs; connect CAS of the DP8429 to CAS of all the DRAMs

Figure 7c illustrates a similar example using the DP8428 to drive two 32-bit banks.





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Applications

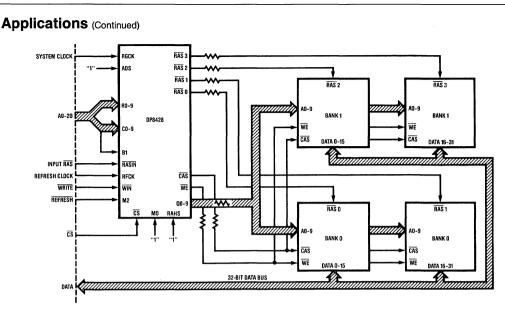
If one desires a memory interface containing the DP8429 that minimizes the number of external components required, modes 5 and 1 should be used. These two modes provide:

- 1) Automatic access to memory (in mode 5 only one signal, RASIN, is required in order to access memory)
- Hidden refresh capability (refreshes are performed automatically while in mode 5 when non-local accesses are taking place, as determined by CS)
- Refresh request capability (if no hidden refresh took place while RFCK was high, a refresh request is generated at the RFI/O pin when RFCK goes high)
- 4) Automatic forced refresh (If a refresh request is generated while in mode 5, as described above, external logic should switch the DP8429 into mode 1 to do an automatic forced refresh. No other external control signals need be issued. WAIT states can be inserted into the processor machine cycles if the system tries to access memory while the DP8429 is in mode 1 doing a forced refresh).

Some items to be considered when integrating the DP8429 into a system design are:

1) The system designer should ensure that a DRAM access not be in progress when a refresh mode is entered. Similarly, one should not attempt to start an access while a refresh is in progress. The parameter t_{RFHRL} specifies the minimum time from $\overline{\text{RFSH}}$ high to $\overline{\text{RASIN}}$ going low to initiate an access.

- One should always guarantee that the DP8429 is enabled for access prior to initiating the access (see t_{CSRL1}).
- One should bring <u>RASIN</u> low even during non-local access cycles when in mode 5 in order to maximize the chance of a hidden refresh occurring.
- 4) At lower frequencies (under 10 Mhz), it becomes increasingly important to differentiate between READ and WRITE cycles. RASIN generation during READ cycles can take place as soon as one knows that a processor READ access cycle has started. WRITE cycles, on the other hand, cannot start until one knows that the data to be written at the DRAM inputs will be valid a setup time before CAS (column address strobe) goes true at the DRAM inputs. Therefore, in general, READ cycles can be initiated earlier than WRITE cycles.
- 5) Many times it is possible to only add WAIT states during READ cycles and have no WAIT states during WRITE cycles. This is because it generally takes less time to write data into memory than to read data from memory.



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FIGURE 7c. Typical Application of DP8428 Using Modes 5 and 1

The DP84XX2 family of inexpensive preprogrammed medium Programmable Array Logic devices (PALs) have been developed to provide an easy interface between various microprocessors and the DP84XX family of DRAM controller/ drivers. These PALs interface to all the necessary control signals of the particular processor and the DP8429. The PAL controls the operation of the DP8429 in modes 5 and 1. while meeting all the critical timing considerations discussed above. The refresh clock, RFCK, may be divided down from the processor clock using an IC counter such as the DM74LS393 or the DP84300 programmable refresh timer. The DP84300 can provide RFCK periods ranging from 15.4 µs to 15.6 µs based on an input clock of 2 to 10 MHz. Figure 8 shows a general block diagram for a system using the DP8429 in modes 1 and 5. Figure 9 shows possible timing diagrams for such a system (using WAIT to prohibit access when refreshing). Although the DP84XX2 PALs are offered as standard peripheral devices for the DP84XX DRAM controller/drivers, the programming equations for these devices are provided so the user may make minor modifications for unique system requirements.

ADVANTAGES OF DP8429 OVER A DISCRETE DYNAMIC RAM CONTROLLER

 The DP8429 system solution takes up much less board space because everything is on one chip (latches, refresh counter, control logic, multiplexers, drivers, and internal delay lines).

- 2) Less effort is needed to design a memory system. The DP8429 has automatic modes (1 and 5) which require a minimum of external control logic. Also programmable array logic devices (PALs) have been designed which allow an easy interface to most popular microprocessors (Motorola 68000 family, National Semiconductor 32032 family, Intel 8086 family, and the Zilog Z8000 family).
- 3) Less skew in memory timing parameters because all critical components are on one chip (many discrete drivers specify a minimum on-chip skew under worst-case conditions, but this cannot be used if more then one driver is needed, such as would be the case in driving a large dynamic RAM array).
- 4) Our switching characteristics give the designer the critical timing specifications based on TTL output levels (low = 0.8V, high = 2.4V) at a specified load capacitance. All timing parameters are specified on the DP8429:
 - A) driving 88 DRAM's over a temperature range of 0–70 degrees centigrade (no extra drivers are needed).
 - B) under worst-case driving conditions with all outputs switching simultaneously (most discrete drivers on the market specify worst-case conditions with only one output switching at a time; this is not a true worst-case condition!).

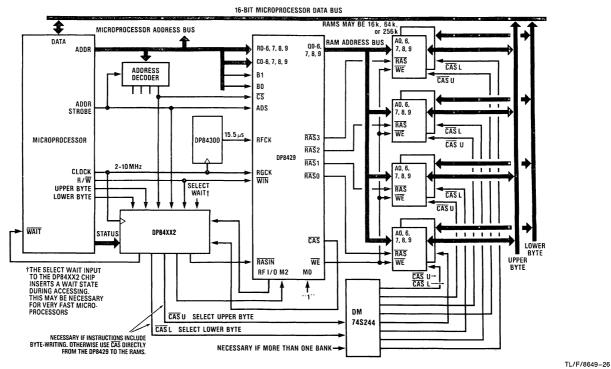
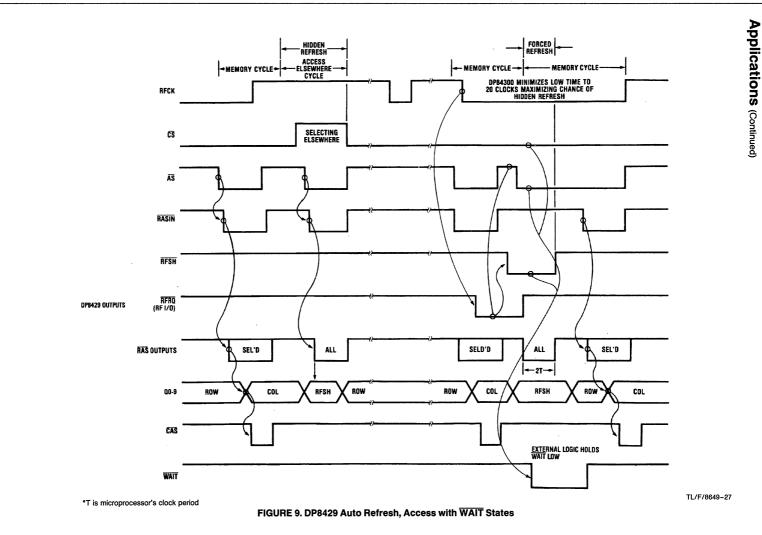


FIGURE 8. Connecting the DP8429 Between the 16-bit Microprocessor and Memory



DP8428/DP8429/NS32828/NS32829

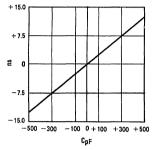


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DP8428/DP8429/NS32828/NS32829

Switching Characteristics

All A. C. parameters are specified with the equivalent load capacitances, including traces, of 88 DRAMs organized as 4 banks of 22 DRAMs each. Maximums are based on worstcase conditions including all outputs switching simultaneously. This, in many cases, results in the AC valves shown in the DP84XX DRAM controller data sheet being much looser than true worst case maximum AC delays. The system designer should estimate the DP8429 load in his/ her application, and modify the appropriate A. C. parameters using the graph in *Figure 10*. Two example calculations are provided below.



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FIGURE 10. Change in Propagation Delay relative to "true" (application) load minus AC specified data sheet load

Examples

- 1) A mode 4 user driving 2 banks of DRAM has the following loading conditions:
 - CAS 300 pF

Q0-Q9 - 250 pF

RAS - 150 pF

A.C. parameters should be adjusted in accordance with *Figure 10* and the specifications given for the 88 DRAM load as follows:

max t_{RPDL} = 20 ns - 0 ns = 20 ns (since \overline{RAS} loading is the same as that which is spec'ed)

max $t_{CPDL} = 32 \text{ ns} - 7 \text{ ns} = 25 \text{ ns}$ max $t_{CCAS} = 46 \text{ ns} - 7 \text{ ns} = 39 \text{ ns}$

 $max t_{BCC} = 41 \text{ ns} - 6 \text{ ns} = 35 \text{ ns}$

min t_{RHA} is not significantly effected since it does not involve an output transition

Other parameters are adjusted in a similar manner.

 A mode 5 user driving one bank of DRAM has the following loading conditions: CAS - 120 pF

Q0-Q9 - 100 pF

RAS - 120 pF

A. C. parameters should be adjusted as follows:

with RAHS = "1",

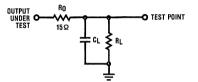
 $max t_{BICL} = 70 ns - 11 ns = 59 ns$

 $max t_{RCDL} = 55 ns + 1 ns - 11 ns = 45 ns$

(the + 1 ns is due to lighter \overline{RAS} loading; the - 11 ns is due to lighter \overline{CAS} loading)

min $t_{BAH} = 15 \text{ ns} + 1 \text{ ns} = 16 \text{ ns}$

The additional 1 ns is due to the fact that the $\overline{\text{RAS}}$ line is driving less (switching faster) than the load to which the 15 ns spec applies. The row address will remain valid for about the same time irregardless of address loading since it is considered to be not valid at the beginning of its transition.



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FIGURE 11. Output Load Circuit

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage, V _{CC}	7.0V
Storage Temperature Range	-65°C to +150°C
Input Voltage	5.5V
Output Current	150 mA
Lead Temp. (Soldering, 10 seconds)	300°C

Operating Conditions

•	•	Min	Max	Units
V _{CC}	Supply Voltage	4.50	5.50	ν
TA	Ambient			
	Temperature	0	+70	°C

Electrical Characteristics $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Note 2)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _C	Input Clamp Voltage	$V_{CC} = Min, I_C = -12 mA$		- 0.8	- 1.2	V
IIH	Input High Current for all Inputs	$V_{IN} = 2.5V$		2.0	100	μΑ
I _I RSI	Output Load Current for RFI/O	V _{IN} = 0.5V, Output high		-0.7	-1.5	mA
I _{IL1}	Input Low Current for all Inputs**	$V_{IN} = 0.5V$		-0.02	-0.25	mA
I _{IL2}	ADS, R/C, CS, M2, RASIN	$V_{IN} = 0.5V$		-0.05	-0.5	mA
VIL	Input Low Threshold				0.8	V
VIH	Input High Threshold		2.0			v
V _{OL1}	Output Low Voltage*	$I_{OL} = 20 \text{ mA}$		0.3	0.5	V
V _{OL2}	Output Low Voltage for RFI/O	I _{OL} = 8 mA		0.3	0.5	V
V _{OH1}	Output High Voltage*	$I_{OH} = -1 \text{ mA}$	2.4	3.5		V
V _{OH2}	Output High Voltage for RFI/O	I _{OH} = - 100 μA	2.4	3.5		V
I _{1D}	Output High Drive Current*	V _{OUT} = 0.8V (Note 3)	-50	- 200		mA
I _{0D}	Output Low Drive Current*	V _{OUT} = 2.4V (Note 3)	50	200		mA
ICC	Supply Current	V _{CC} = Max		150	240	mA

*Except RFI/O

**Except RFI/O, ADS, R/C, CS, M2, RASIN

Switching Characteristics: DP8428 and DP8429

 $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5), the output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q9, $C_L = 500 \text{ pF}$; $\overline{RAS0} - \overline{RAS3}$, $C_L = 150 \text{ pF}$; \overline{WE} , $C_L = 500 \text{ pF}$; \overline{CAS} , $C_L = 600 \text{ pF}$; $RL = 500 \Omega$ unless otherwise noted. See *Figure 11* for test load. Maximum propagation delays are specified with all outputs switching.

** Preliminary

Symbol	Access Parameter	Condition	*CL		**All C _L	= 50 pF	Units
Cymbol	Addess Furdineter	Condition	Min	Max	Min	Max	
t _{RICL0}	$\frac{\text{RASIN}}{\text{(RAHS)}} \text{ to } \frac{\text{CAS}}{\text{CAS}} \text{ Low Delay}$	<i>Figure 6</i> DP8428-80/29-80	57	97	42	85	ns
t _{RICL0}	$\frac{\text{RASIN}}{\text{(RAHS}} \text{ to } \overline{\text{CAS}} \text{ Low Delay}$	<i>Figure 6</i> DP8428-70/29-70	57	87	42	75	ns
t _{RICL1}	$\frac{\text{RASIN}}{\text{(RAHS)}} \text{ to } \frac{\text{CAS}}{\text{Low Delay}}$	<i>Figure 6</i> DP8428-80/29-80	48	80	35	68	ns
t _{RICL1}	$\overline{\text{RASIN}} \text{ to } \overline{\text{CAS}} \text{ Low Delay} \\ (\text{RAHS} = 1)$	<i>Figure 6</i> DP8428-70/29-70	48	70	35	58	ns
t _{RICH}	RASIN to CAS High Delay	Figure 6		37			ns
t _{RCDL0}	\overline{RAS} to \overline{CAS} Low Delay (RAHS = 0)	<i>Figure 6</i> DP8428-80/29-80	43	80			ns
t _{RCDL0}	\overline{RAS} to \overline{CAS} Low Delay (RAHS = 0)	<i>Figure 6</i> DP8428-70/29-70	43	72			ns

Switching Characteristics: DP8428 and DP8429 (Continued)

 $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5), the output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q9, $C_L = 500 \text{ pF}$; $\overline{RAS0} - \overline{RAS3}$, $C_L = 150 \text{ pF}$; \overline{WE} , $C_L = 500 \text{ pF}$; \overline{CAS} , $C_L = 600 \text{ pF}$; $RL = 500 \Omega$ unless otherwise noted. See *Figure 11* for test load. Maximum propagation delays are specified with all outputs switching.

** Preliminary

Symbol	Access Parameter	Condition	*	CL	**All CL	= 50 pF	- Units
-,			Min	Max	Min	Max	
t _{RCDL1}	\overline{RAS} to \overline{CAS} Low Delay (RAHS = 1)	<i>Figure 6</i> DP8428-80/29-80	34	63			ns
tRCDL1	$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Low Delay (RAHS = 1)	<i>Figure 6</i> DP8428-70/29-70	34	55			ns
t _{RCDH}	RAS to CAS High Delay	Figure 6		22			ns
t _{RAH0}	Row Address Hold Time (RAHS = 0, Mode 5)	Figure 6	25		25		ns
t _{RAH1}	Row Address Hold Time (RAHS = 1, Mode 5)	Figure 6	15		15		ns
tASC	Column Address Set-up Time (Mode 5)	Figure 6	0		0		ns
t _{RCV0}	$\overline{\text{RASIN}}$ to Column Address Valid (RAHS = 0, Mode 5)	<i>Figure 6</i> DP8428-80/29-80		94			ns
t _{RCV0}	\overline{RASIN} to Column Address Valid (RAHS = 0, Mode 5)	<i>Figure 6</i> DP8428-70/29-70		85			ns
t _{RCV1}	$\overline{\text{RASIN}}$ to Column Address Valid (RAHS = 1, Mode 5)	<i>Figure 6</i> DP8428-80/29-80		76			ns
t _{RCV1}	$\overline{\text{RASIN}}$ to Column Address Valid (RAHS = 1, Mode 5)	<i>Figure 6</i> DP8428-70/29-70		68			ns
t _{RPDL}	RASIN to RAS Low Delay	Figures 5a, 5b, 6		21		18	ns
t _{RPDH}	RASIN to RAS High Delay	Figures 5a, 5b, 6		20		17	ns
tASRL	Address Set-up to RASIN low	Figures 5a, 5b, 6	13				ns
tAPD	Address Input to Output Delay	Figures 5a, 5b, 6		36		25	ns
t _{SPD}	Address Strobe High to Address Output Valid	Figures 5a, 5b		48	·		ns
t _{ASA}	Address Set-up Time to ADS	Figures 5a, 5b, 6	5				ns
t _{AHA}	Address Hold Time from ADS	Figures 5a, 5b, 6	10				ns
t _{ADS}	Address Strobe Pulse Width	Figures 5a, 5b, 6	26				ns
twpD	WIN to WE Output Delay	Figure 5b		28			ns
t _{CPDL}	\overline{CASIN} to \overline{CAS} Low Delay (R/ \overline{C} low, Mode 4)	Figure 5b	· 17	33			ns
t _{CPDH}	CASIN to CAS High Delay (R/C low, Mode 4)	Figure 5b	13	33			ns
t _{CPdif}	tCPDL - tCPDH	See Mode 4 Description		13			ns
t _{RCC}	Column Select to Column Address Valid	Figure 5a		41			ns
t _{RCR}	Row Select to Row Address Valid	Figures 5a, 5b		45			ns
t _{RHA}	Row Address Held from Column Select	Figure 5a	7				ns
t _{CCAS}	R/C Low to CAS Low Delay (CASIN Low, Mode 4)	<i>Figure 5a</i> DP8428-80/29-80		50			ns
tCCAS	R/C Low to CAS Low Delay (CASIN Low, Mode 4)	<i>Figure 5a</i> DP8428-70/29-70		46			ns
t _{DIF1}	Maximum (t _{RPDL} - t _{RHA})	See Mode 4 Description		7			ns
t _{DIF2}	Maximum (t _{RCC} - t _{CPDL})	· · · · · · · · · · · · · · · · · · ·		13			ns

Switching Characteristics: DP8428 and DP8429 (Continued)

 $V_{CC} = 5.0V \pm 10\%$, 0°C $\leq T_A \leq 70$ °C unless otherwise noted (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q9, $C_L = 500 \text{ pF}$; $\overline{RAS0} - \overline{RAS3}$, $C_L = 150 \text{ pF}$; \overline{WE} , $C_L = 500 \text{ pF}$; \overline{CAS} , $C_L = 600 \text{ pF}$; $RL = 500\Omega$ unless otherwise noted. See *Figure 11* for test load. Maximum propagation delays are specified with all outputs switching.

**Preliminary

Symbol	Refresh Parameter	Condition	*CL		**All CL	= 50 pF	Units
-,			Min	Max	Min	Max	
t _{RC}	Refresh Cycle Period	Figure 2a	100				ns
^t RASINL,H	Pulse Width of RASIN during Refresh	Figure 2a	50				ns
RFPDL0	RASIN to RAS Low Delay during Refresh (Mode 0)	Figure 2a		28			ns
RFPDL5	RASIN to RAS Low Delay during Hidden Refresh	Figure 7		38			ns
RFPDH0	RASIN to RAS High Delay during Refresh (Mode 0)	Figure 2a		35			ns
RFPDH5	RASIN to RAS High Delay during Hidden Refresh	Figure 7		44			ns
RFLCT	RFSH Low to Counter Address Valid	<i>Figures 2a, 3</i> TCS = X		38			ns
RFLRL	$\begin{tabular}{l} \hline $RFSH$ Low Set-up to $RASIN$ Low (Mode 0), to get $$Minimum t_{ASR} = 0$$ \end{tabular}$	Figure 2a	12				ns
t _{RFHRL} RFSH High Setup to Access RASIN Low		Figure 3	25				ns
t _{RFHRV} RFSH High to Row Address Valid		Figure 3		43			ns
ROHNC	RAS High to New Count Valid	Figure 2a		42			ns
RST	Counter Reset Pulse Width	Figure 2a	60				ns
^I CTL	RFI/O Low to Counter Outputs All Low	Figure 2a		100			ns
^I RFCKL,H	Minimum Pulse Width of RFCK	Figure 7	100				ns
Т	Period of RAS Generator Clock	Figure 3	30				ns
RGCKL	Minimum Pulse Width Low of RGCK	Figure 3	15				ns
RGCKH	Minimum Pulse Width High of RGCK	Figure 3	15				ns
FRQL	RFCK Low to Forced RFRQ (RFI/O) Low	<i>Figure 3</i> C _L = 50 pF RL = 35k		66			ns
FRQH	RGCK Low to Forced RFRQ High	<i>Figure 3</i> C _L = 50 pF RL = 35k		55			ns

Switching Characteristics: DP8428 and DP8429 (Continued)

 V_{CC} = 5.0V ± 10%, 0°C ≤ T_A ≤ 70°C unless otherwise noted (Notes 2, 4, 5). The output load capacitance is typical for 4 banks of 22 DRAMs each or 88 DRAMs, including trace capacitance.

* These values are Q0-Q9, C_L = 500 pF; RAS0-RAS3, C_L = 150 pF; \overline{WE} , C_L = 500 pF; \overline{CAS} , C_L = 600 pF; RL = 500 Ω unless otherwise noted. See *Figure 11* for test load. Maximum propagation delays are specified with all outputs switching.

**Preliminary

Symbol	Refresh Parameter	Condition	*	CL	**All CL	= 50 pF	Units
Cymbol		Condition	Min	Max	Min	Max	
tRGRL	RGCK Low to RAS Low	Figure 3	20	41			ns
t _{RGRH}	RGCK Low to RAS High	Figure 3	20	48			ns
^t RQHRF	RFSH Hold Time from RGCK	Figure 3	2T				ns
t _{RFRH} RFSH High to RAS High (See Mode 1 42 (Ending Forced Refresh Description) early)				ns			
^t RFSRG	t _{RFSRG} RFSH Low Set-up to RGCK Low (Mode 1)		12				ns
^t CSHR	CS High to RASIN Low for Hidden Refresh	Figure 7	10				ns
^t CSRL1 for DP8429	CS Low to Access RASIN Low (Using Mode 5 with Auto Refresh Mode)	Figure 3	34				ns
tCSRL1 for DP8428	CS Low to Access RASIN Low (Using Mode 5 with Auto Refresh Mode)	Figure 3	5		_		ns
^t CSRL0	CS Low to Access RASIN Low (Using Modes 4 or 5 with externally controlled Refresh)	(See Mode 5 Description)	5				ns
^t RKRL	RFCK High to RASIN low for hidden Refresh		50				ns

Input Capacitance T_A = 25°C (Note 2)

Symbol	Parameter	Condition	Min	Тур	Max	Units
C _{IN}	Input Capacitance ADS, R/C, CS, M2, RASIN			8		pF
C _{IN}	Input Capacitance All Other Inputs			5		pF

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: All typical values are for $T_A = 25^{\circ}C$ and $V_{CC} = 5.0V$.

Note 3: This test is provided as a monitor of Driver output source and sink current capability. Caution should be exercised in testing this parameter. In testing these parameters, a 15 Ω resistor should be placed in series with each output under test. One output should be tested at a time and test time should not exceed 1 second. Note 4: Input pulse 0V to 3.0V, t_R=t_F=2.5 ns, f=2.5 MHz, t_{PW}=200 ns. Input reference point on AC measurements is 1.5V Output reference points are 2.4V for High and 0.8V for Low.

Note 5: The load capacitance on RF I/O should not exceed 50 pF.

National Semiconductor

DP8420A/21A/22A microCMOS Programmable 256k/1M/4M Dynamic RAM Controller/Drivers

General Description

The DP8420A/21A/22A dynamic RAM controllers provide a low cost, single chip interface between dynamic RAM and all 8-, 16- and 32-bit systems. The DP8420A/21A/22A generate all the required access control signal timing for DRAMs. An on-chip refresh request clock is used to automatically refresh the DRAM array. Refreshes and accesses are arbitrated on chip. If necessary, a WAIT or DTACK output inserts wait states into system access cycles, including burst mode accesses. RAS low time during refreshes and RAS precharge time after refreshes and back to back accesses are guaranteed through the insertion of wait states. Separate on-chip precharge counters for each RAS output can be used for memory interleaving to avoid delayed back to back accesses because of precharge. An additional feature of the DP8422A is two access ports to simplify dual accessing. Arbitration among these ports and refresh is done on chip.

Features

- On chip high precision delay line to guarantee critical DRAM access timing parameters
- microCMOS process for low power
- High capacitance drivers for RAS, CAS, WE and DRAM address on chip
- On chip support for nibble, page and static column DRAMs
- Byte enable signals on chip allow byte writing in a word size up to 32 bits with no external logic
- Selection of controller speeds: 20 MHz and 25 MHz
- On board Port A/Port B (DP8422A only)/refresh arbitration logic
- Direct interface to all major microprocessors (application notes available)
- 4 RAS and 4 CAS drivers (the RAS and CAS configuration is programmable)

Control	# of Pins (PLCC)	# of Address Outputs	Largest DRAM Possible	Direct Drive Memory Capacity	Access Ports Available
DP8420A	68	9	256 kbit	4 Mbytes	Single Access Port
DP8421A	68	10	1 Mbit	16 Mbytes	Single Access Port
DP8422A	84	11	4 Mbit	64 Mbytes	Dual Access Ports (A and B)

Block Diagram

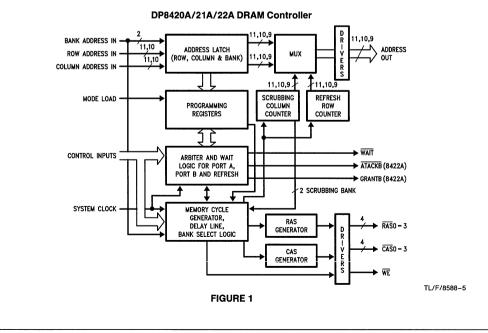


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1.0 Introduction

The DP8420A/21A/22A are CMOS Dynamic RAM controllers that incorporate many advanced features which include address latches, refresh counter, refresh clock, row, column and refresh address multiplexer, delay line, refresh/access arbitration logic and high capacitive drivers. The programmable system interface allows any manufacturer's microprocessor or bus to directly interface via the DP8420A/21A/22A to DRAM arrays up to 64 Mbytes in size.

After power up, the user must first reset and program the DP8420A/21A/22A before accessing the DRAM. The chip is programmed through the address bus.

Reset:

Due to the differences in power supplies, the internal reset circuit may not always reset correctly; therefore, an External (hardware) Reset must be performed before programming the chip.

Programming:

After resetting the chip, the user can program the controller by either one of two methods: Mode Load Only Programming or Chip Select Access Programming.

Initialization Period:

Once the DP8420A/21A/22A has been programmed for the first time, a 60 ms initialization period is entered. During this time the DRC performs refreshes to the DRAM array so further warm up cycles are unnecessary. The initialization period is entered only after the first programming after a reset.

Accessing Modes:

After resetting and programming the chip, the DP8420A/21A/22A is ready to access the DRAM. There are two modes of accessing with these controllers. Mode 0, which indicates RAS synchronously and Mode 1, which indicates RAS asynchronously.

Refresh Modes:

The DP8420A/21A/22A have expanded refresh capabilities compared to previous DRAM controllers. There are three modes of refreshing available: Internal Automatic Refreshing, Externally Controlled/Burst Refreshing and Refresh Request/Acknowledge Refreshing. Any of these modes can be used together or separately to achieve the desired results.

Refresh Types:

These controllers have three types of refreshing available: Conventional, Staggered and Error Scrubbing. Any refresh control mode can be used with any type of refresh.

Wait Support:

The DP8420A/21A/22A have wait support available as DTACK or WAIT. Both are programmable. DTACK, Data Transfer ACKnowledge, is useful for processors whose wait signal is active high. WAIT is useful for those processors whose wait signal is active low. The user can choose either at programming. These signals are used by the on chip arbiter to insert wait states to guarantee the arbitration between accesses, refreshes and precharge. Both signals are independent of the access mode chosen and both signals can be dynamically delayed further through the WAITIN signal to the DP8420A/21A/22A.

Sequential Accesses (Static Column/Page Mode):

The DP8420A/21A/22A have address latches, used to latch the bank, row and column address inputs. Once the address is latched, a COLumn INCrement (COLINC) feature can be used to increment the column address. The address latches can also be programmed to be fall through. COLINC can be used for Sequential Accesses of Static Column DRAMs. Also, COLINC in conjunction with ECAS inputs can be used for Sequential Accesses to Page Mode DRAMs.

RAS and **CAS** Configuration (Byte Writing):

The \overrightarrow{RAS} and \overrightarrow{CAS} drivers can be configured to drive a one, two or four bank memory array up to 32 bits in width. The \overrightarrow{ECAS} signals can then be used to select one of four \overrightarrow{CAS} drivers for Byte Writing with no extra logic.

Memory Interleaving:

When configuring the DP820A/21A/22A for more than one bank, Memory Interleaving can be used. By tying the low order address bits to the bank select lines B0 and B1, sequential back to back accesses will not be delayed since these controllers have separate precharge counters per bank.

Address Pipelining:

The DP8420A/21A/22A are capable of performing Address Pipelining. In address pipelining, the DRC will guarantee the column address hold time and switch the internal multiplexor to place the row address on the address bus. At this time, another memory access to another bank can be initiated.

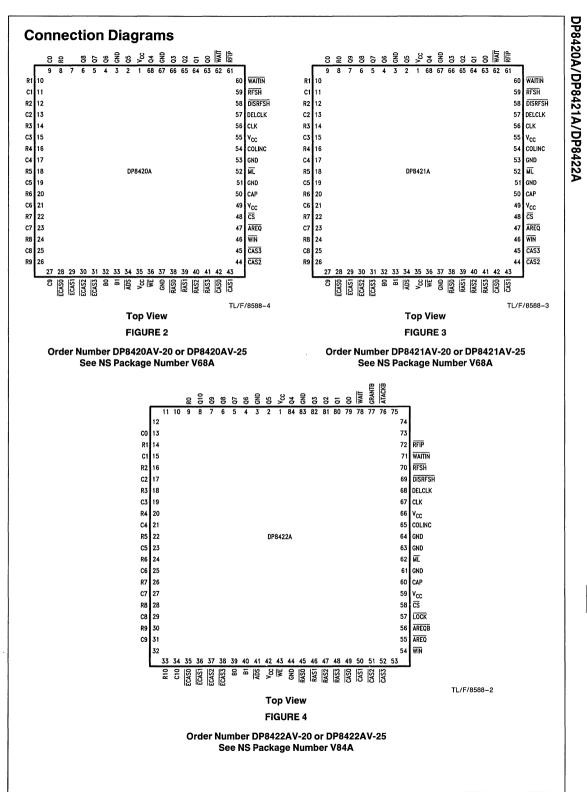
Dual Accessing:

Finally, the DP8422A has all the features previously mentioned and unlike the DP8420A/21A, the DP8422A has a second port to allow a second CPU to access the same memory array. The DP8422A has four signals to support Dual Accessing, these signals are AREOB, ATACKB, LOCK and GRANTB. All arbitration for the two ports and refresh is done on chip by the controller through the insertion of wait states. Since the DP8422A has only one input address bus, the address lines must be multiplexed externally. The signal GRANTB can be used for this purpose.

Terminology:

The following explains the terminology used in this data sheet. The terms negated and asserted are used. Asserted refers to a "true" signal. Thus, "ECASO asserted" means the ECASO input is at a logic 0. The term "COLINC asserted" means the COLINC input is at a logic 1. The term negated refers to a "false" signal. Thus, "ECASO negated" means the ECASO input is at a logic 1. The term "COLINC negated" means the input COLINC is at a logic 0. The term "COLINC shown below clarifies this terminology.

Signal	Action	Logic Level
Active High	Asserted	High
Active High	Negated	Low
Active Low	Asserted	Low
Active Low	Negated	High



Pin Name	Device (If not Applicable to All)	Input/ Output	Description
2.1 ADDRESS	, R/W AND PROGRA	AMMING S	SIGNALS
R0–10 R0–9	DP8422A DP8420A/21A	1	ROW ADDRESS: These inputs are used to specify the row address during an access to the DRAM. They are also used to program the chip when $\overline{\text{ML}}$ is asserted (except R10).
C0-10 C0-9	DP8422A DP8420A/21A	1	COLUMN ADDRESS: These inputs are used to specify the column address during an access to the DRAM. They are also used to program the chip when ML is asserted (except C10).
B0, B1		I	BANK SELECT: Depending on programming, these inputs are used to select a group of $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ outputs to assert during an access. They are also used to program the chip when $\overline{\text{ML}}$ is asserted.
ECAS0-3		l	ENABLE CAS: These inputs are used to enable a single or group of CAS outputs when asserted. In combination with the B0, B1 and the programming bits, these inputs select which CAS output or CAS outputs will assert during an access. The ECAS signals can also be used to toggle a group of CAS outputs for page/nibble mode accesses. They also can be used for byte write operations. If ECAS0 is negated during programming, continuing to assert the ECAS0 while negating AREQ or AREOB during an access, will cause the CAS outputs to be extended while the RAS outputs are negated (the ECASn inputs have no effect during scrubbing refreshes).
WIN		1	WRITE ENABLE IN: This input is used to signify a write operation to the DRAM. If ECAS0 is asserted during programming, the WE output will follow this input. This input asserted will also cause \overline{CAS} to delay to the next positive clock edge if address bit C9 is asserted during programming.
COLINC (EXTNDRF)		1	COLUMN INCREMENT: When the address latches are used, and \overrightarrow{RFIP} is negated, this input functions as COLINC. Asserting this signal causes the column address to be incremented by one. When \overrightarrow{RFIP} is asserted, this signal is used to extend the refresh cycle by any number of periods of CLK until it is negated.
ML		Ι	MODE LOAD: This input signal, when low, enables the internal programming register that stores the programming information.
2.2 DRAM CO	NTROL SIGNALS		
Q0-10 Q0-9 Q0-8	DP8422A DP8421A DP8421A	000	DRAM ADDRESS: These outputs are the multiplexed output of the R0–9, 10 and C0–9, 10 and form the DRAM address bus. These outputs contain the refresh address whenever RFIP is asserted. They contain high capacitive drivers with 20Ω series damping resistors.
RAS0-3		0	ROW ADDRESS STROBES: These outputs are asserted to latch the row address contained on the outputs Q0–8, 9, 10 into the DRAM. When RFIP is asserted, the RAS outputs are used to latch the refresh row address contained on the Q0–8, 9, 10 outputs in the DRAM. These outputs contain high capacitive drivers with 20 Ω series damping resistors.
CAS0-3		0	COLUMN ADDRESS STROBES: These outputs are asserted to latch the column address contained on the outputs $Q0-8$, 9, 10 into the DRAM. These outputs have high capacitive drivers with 20Ω series damping resistors.
WE (RFRQ)		0 0	WRITE ENABLE or REFRESH REQUEST: This output asserted specifies a write operation to the DRAM. When negated, this output specifies a read operation to the DRAM. When the DP8420A/21A/22A is programmed in address pipelining mode or when ECAS0 is negated during programming, this output will function as RFRQ. When asserted, this pin specifies that 13 μ s or 15 μ s have passed. If DISRFSH is negated, the DP8420A/21A/22A will perform an internal refresh as soon as possible. If DISRFRSH is asserted, RFRQ can be used to externally request a refresh through the input RFSH. This output has a high capacitive driver and a 20 Ω series damping resistor.

Pin Name	Device (If not Applicable to All)	Input/ Output	Description
2.3 REFRES	HSIGNALS		
RFIP		0	REFRESH IN PROGRESS: This output is asserted prior to a refresh cycle and is negated when all the RAS outputs are negated for that refresh.
RFSH		Ι	REFRESH: This input asserted with DISRFRSH already asserted will request a refresh. If this input is continually asserted, the DP8420A/21A/22A will perform refresh cycles in a burst refresh fashion until the input is negated. If RFSH is asserted with DISRFSH negated, the internal refresh address counter is cleared (useful for burst refreshes).
DISRFSH		I	DISABLE REFRESH: This input is used to disable internal refreshes and must be asserted when using RFSH for externally requested refreshes.
2.4 PORT A	ACCESS SIGNALS		
ADS (ALE)		1	ADDRESS STROBE or ADDRESS LATCH ENABLE: Depending on programming, this input can function as ADS or ALE. In mode 0, the input functions as ALE and when asserted along with CS causes an internal latch to be set. Once this latch is set an access will start from the positive clock edge of CLK as soon as possible. In Mode 1, the input functions as ADS and when asserted along with CS, causes the access RAS to assert if no other event is taking place. If an event is taking place, RAS will be asserted from the positive edge of CLK as soon as possible. In both cases, the low going edge of this signal latches the bank, row and column address if programmed to do so.
CS		1	CHIP SELECT: This input signal must be asserted to enable a Port A access.
AREQ		1	ACCESS REQUEST: This input signal in Mode 0 must be asserted some time after the first positive clock edge after ALE has been asserted. When this signal is negated, RAS is negated for the access. In Mode 1, this signal must be asserted before ADS can be negated. When this signal is negated, RAS is negated for the access.
WAIT (DTACK)		0	WAIT or DTACK: This output can be programmed to insert wait states into a CPU access cycle. With R7 negated during programming, the output will function as a WAIT type output. In this case, the output will be active low to signal a wait condition. With R7 asserted during programming, the output will function as DTACK. In this case, the output will be active low to signal a wait condition. With R7 asserted during programming, the output will function as DTACK. In this case, the output will be active low to signal a wait condition. With R7 asserted during programming, the output will function as DTACK. In this case, the output will be asserted to signify the access has taken place. Each of these signals can be delayed by a number of positive clock edges or negative clock levels of CLK to increase the microprocessor's access cycle through the insertion of wait states.
WAITIN		I	WAIT INCREASE: This input can be used to dynamically increase the number of positive clock edges of CLK until DTACK will be asserted or WAIT will be negated during a DRAM access.

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422A	2.0 Signal D				
V/DP8	Pin Name	Devic Applica			
214	2.5 PORT B	ACCESS			
DP8420A/DP8421A/DP8422A	AREQB	DP8422 only			
DP842(ATACKB	DP8422 only			
	2.6 COMMO	N DUAL			
	GRANTB	DP842			

Pin Name	Device (If not Applicable to All)	Input/ Output	Description		
2.5 PORT B	ACCESS SIGNALS	1			
AREQB	QB DP8422A I only		PORT B ACCESS REQUEST: This input asserted will latch the row, column and ban address if programmed, and requests an access to take place for Port B. If the access can take place, RAS will assert immediately. If the access has to be delayed, RAS will assert as soon as possible from a positive edge of CLK.		
ATACKB	DP8422A only	0	ADVANCED TRANSFER ACKNOWLEDGE PORT B: This output is asserted when the access RAS is asserted for a Port B access. This signal can be used to generate the appropriate DTACK or WAIT type signal for Port B's CPU or bus.		
2.6 COMMO	N DUAL PORT SIGN	ALS	· · · ·		
GRANTB	DP8422A only	0	GRANT B: This output indicates which port is currently granted access to the DRAM. array. When GRANTB is asserted, Port B has access to the array. When GRANTB is negated, Port A has access to the DRAM array. This signal is used to multiplex the signals R0–8, 9, 10; C0–8, 9, 10; B0–1; WIN; LOCK and ECAS0–3 to the DP8422A when using dual accessing.		
LOCK	DP8422A only	1	LOCK: This input can be used by the currently granted port to "lock out" the other port from the DRAM array by inserting wait states into the locked out port's access cycle until LOCK is negated.		
2.7 POWER	SIGNALS AND CAP	ACITOR IN	PUT		
V _{CC}		1	POWER: Supply Voltage.		
GND		I	GROUND: Supply Voltage Reference.		
CAP		I	CAPACITOR: This input is used by the internal PLL for stabilization. The value of the ceramic capacitor should be 0.1 μ F and should be connected between this input and ground.		
There are			A/21A/22A, CLK and DELCLK. These two clocks may both be tied to the same clock s, running at different frequencies, asynchronous to each other.		
CLK		Ι	SYSTEM CLOCK: This input may be in the range of 0 Hz up to 25 MHz. This input is generally a constant frequency but it may be controlled externally to change frequencies or perhaps be stopped for some arbitrary period of time. This input provides the clock to the internal state machine that arbitrates between accesses and refreshes. This clock's positive edges and negative levels are used to extend the WAIT (DTACK) signals. Ths clock is also used as the reference for the RAS precharge time and RAS low time during refresh. All Port A and Port B accesses are assumed to be synchronous to the system clock CLK.		
DELCLK			DELAY LINE CLOCK: The clock input DELCLK, may be in the range of 6 MHz to 20 MHz and should be a multiple of 2 (i.e., 6, 8, 10, 12, 14, 16, 18, 20 MHz) to have the DP8420A/21A/22A switching characteristics hold. If DELCLK is not one of the above frequencies the accuracy of the internal delay line will suffer. This is because the phase locked loop that generates the delay line assumes an input clock frequency of a multiple of 2 MHz. For example, if the DELCLK input is at 7 MHz and we choose a divide by 3 (program bits C0–2) this will produce 2.333 MHz which is 16.667% off of 2 MHz. Therefore, the DP8420A/21A/22A delay line would produce delays that are shorter (faster delays) than what is intended. If divide by 4 was chosen the delay line would be longer (slower delays) than intended (1.75 MHz instead of 2 MHz). (See Section 10 for more information.) This clock is also divided to create the internal refresh clock.		

3.0 Programming and Resetting

Due to the variety in power supplies power-up times, the internal power up reset circuit may not work in every design; therefore, an EXTERNAL RESET must be performed before the DRAM controller can be programmed and used.

procedure. through the reset After nninn the DP8420A/21A/22A can be programmed by either of two methods: Mode Load Only Programming or Chip Select Access Programming. After programming the DRC for the first time after reset, the chip enters a 60 ms initialization period, during this period the controller performs refreshes every 13 μ s or 15 μ s, this makes further DRAM warm up cycles unnecessary. After this stage the chip can be reprogrammed as many times as the user wishes and the 60 ms period will not be entered into unless the chip is reset and programmed again.

During the 60 ms initialization period, $\overline{\text{RFIP}}$ is asserted low and $\overline{\text{RAS}}$ toggles every 13 μ s or 15 μ s depending on the programming bit for refresh (C3). $\overline{\text{CAS}}$ will be inactive (logic 1) and the "Q" outputs will count from 0 to 2047 refreshing the entire DRAM array. The actual initialization time period is given by the following formula. T = 4096* (Clock Divisor Select)* (Refresh Clock Fine Tune)/(DELCLK Frq.)

3.1 EXTERNAL RESET

At power up, if the internal power up reset worked, all internal latches and flip-flops are cleared and the part is ready to be programmed. The power up state can also be achieved by performing an External Reset, which is required to insure proper operation. External Reset is achieved by asserting ML and DISRFSH for at least 16 positive clock edges. In order to perform simply a Reset, the ML signal must be negated before DISRFSH is negated as shown in *Figure 5a*. This procedure will only reset the controller which now is ready for programming.

While performing an External Reset, if the user negates DISRFSH at least one clock period before negating \overline{ML} , as shown in *Figure 5b*, \overline{ML} negated will program the DP8420A/21A/22A with the values in R0–9, C0–9, B0–1 and ECAS0. The 60 ms initialization period will be entered since it is the first programming after reset. This is a good way of resetting and programming the part at the same time. Make sure the right programming bits are on the address lines before \overline{ML} is negated.

The DRC may be Reset and programmed any time on the fly, but the user must make sure that No Access or Refresh is in progress.

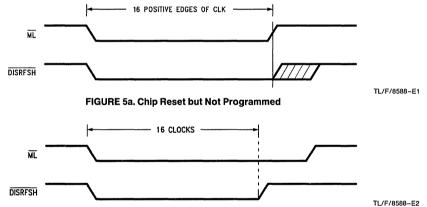


FIGURE 5b. Chip Reset and Programmed

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3.0 Programming and Resetting (Continued)

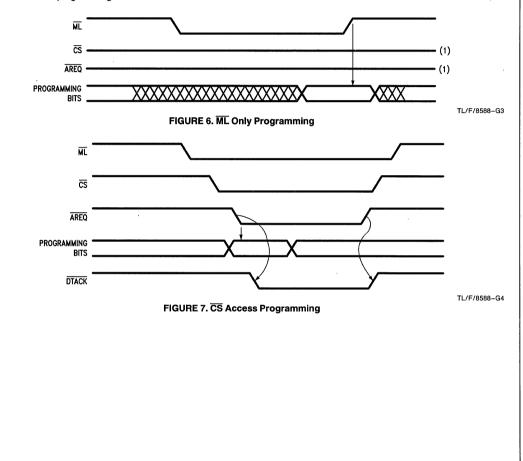
3.2 PROGRAMMING METHODS

3.2.1 Mode Load Only Programming

To use this method the user asserts \overline{ML} enabling the internal programming register. After \overline{ML} is asserted, a valid programming selection is placed on the address bus, B0, B1 and ECAS0 inputs, then \overline{ML} is negated. When \overline{ML} is negated the programming bits are latched into the internal programming register and the DP8420A/21A/22A is programmed, see *Figure 6*. When programming the chip, the controller must not be refreshing, RFIP must be high (1) to have a successful programming.

3.2.2 Chip Selected Access Programming

The chip can also be programmed by performing a chip selected access. To program the chip using this method, $\overline{\text{ML}}$ is asserted, then $\overline{\text{CS}}$ is asserted and a valid programming selection is placed on the address bus. When $\overline{\text{AREQ}}$ is asserted, the programming bits affecting the wait logic become effective immediately, then $\overline{\text{DTACK}}$ is asserted allowing the access to terminate. After the access, $\overline{\text{ML}}$ is negated and the rest of the programming bits take effect.



DP8420A/DP8421A/DP8422A

3.0 Programming and Resetting (Continued)

3.3 PROGRAMMING BIT DEFINITIONS

Symbol	/mbol Description				
ECAS0	Extend CAS/Refresh Request Select				
0	The CASn outputs will be negated with the RASn outputs when AREQ (or AREQB, DP8422A only) is negated. The WE output pin will function as write enable.				
1	The CASn outputs will be negated, during an acccess (Port A (or Port B, DP8422A only)) when their corresponding ECASn inputs are negated. This feature allows the CAS outputs to be extended beyond the RAS outputs negating. Scrubbing refreshes are NOT affected. During scrubbing refreshes the CAS outputs will negate along with the RAS outputs regardless of the state of the ECAS inputs. The WE output will function as ReFresh ReQuest (RFRQ) when this mode is programmed.				
B1	Access Mode Select				
0	ACCESS MODE 0: ALE pulsing high sets an internal latch. On the next positive edge of CLK, the access (RAS) will start. AREQ will terminate the access. ACCESS MODE 1: ADS asserted starts the access (RAS) immediately. AREQ will terminate the access.				
B0	Address Latch Mode				
0	ADS or ALE asserted for Port A or AREQB asserted for Port B with the appropriate GRANT latch the input row, column and bank address.				
1	The row, column and bank latches are fall through.				
C9	Delay CAS during WRITE Accesses				
0	CAS is treated the same for both READ and WRITE accesses. During WRITE accesses, CAS will be asserted by the event that occurs last: CAS asserted by the internal delay line or CAS asserted on the positive edge of CLK after RAS is asserted.				
C8	Row Address Hold Time				
0	Row Address Hold Time = 25 ns minimum Row Address Hold Time = 15 ns minimum				
C7	Column Address Setup Time				
0	Column Address Setup Time = 10 ns miniumum				
1	Column Address Setup Time = 0 ns minimum				
C6, C5, C4	RAS and CAS Configuration Modes/Error Scrubbing during Refresh				
0, 0, 0	RAS0-3 and CAS0-3 are all selected during an access. ECASn must be asserted for CASn to be asserted.				
0, 0, 1	B0 and B1 are not used during an access. Error scrubbing during refresh. RAS and CAS pairs are selected during an access by B1. ECASn must be asserted for CASn to be asserted. B1 = 0 during an access selects RAS0-1 and CAS0-1. B1 = 1 during an access selects RAS2-3 and CAS2-3. B0 is not used during an Access.				
0, 1, 0	 Error scrubbing during refresh. RAS and CAS singles are selected during an access by B0–1. ECASn must be asserted for CASn to be asserted B1 = 0, B0 = 0 during an access selects RAS0 and CAS0. B1 = 0, B0 = 1 during an access selects RAS1 and CAS1. B1 = 1, B0 = 0 during an access selects RAS2 and CAS2. B1 = 1, B0 = 1 during an access selects RAS3 and CAS3. Error scrubbing during refresh. 				
0, 1, 1	RAS0-3 and CAS0-3 are all selected during an access. ECASn must be asserted for CASn to be asserted. B1, B0 are not used during an access. No error scrubbing. (RAS only refreshing)				
1, 0, 0	RAS pairs are selected by B1. CAS0-3 are all selected. ECASn must be asserted for CASn to be asserted. B1 = 0 during an access selects RAS0-1 and CAS0-3. B1 = 1 during an access selects RAS2-3 and CAS0-3. B0 is not used during an access.				

3.0 Programming and Resetting (Continued)

Symbol	Description
C6, C5, C4	RAS and CAS Configuration Modes (Continued)
1, 0, 1	RAS and CAS pairs are selected by B1. ECASn must be asserted for CASn to be asserted. B1 = 0 during an access selects RAS0-1 and CAS0-1. B1 = 1 during an access selects RAS2-3 and CAS2-3.
	B0 is not used during an access.
1, 1, 0	No error scrubbing. RAS singles are selected by B0-1. CAS0-3 are all selected. ECASn must be asserted for CASn to be asserted.
	B1 = 0, B0 = 0 during an access selects $\overline{RAS}0$ and $\overline{CAS}0-3$.
	B1 = 0, B0 = 1 during an access selects \overline{RAS} 1 and \overline{CAS} 0-3.
	$B1 = 1, B0 = 0$ during an access selects $\overline{RAS2}$ and $\overline{CAS0} - 3$.
	$B1 = 1, B0 = 1$ during an access selects $\overline{RAS3}$ and $\overline{CAS0}$ -3.
	No error scrubbing.
1, 1, 1	RAS and CAS singles are selected by B0, 1. ECASn must be asserted for CASn to be asserted.
	$B1 = 0, B0 = 0$ during an access selects $\overline{RAS0}$ and $\overline{CAS0}$.
	B1 = 0, B0 = 1 during an access selects RAS1 and CAS1.
	B1 = 1, B0 = 0 during an access selects RAS2 and CAS2.
	B1 = 1, B0 = 1 during an access selects RAS3 and CAS3.
	No error scrubbing.
C3	Refresh Clock Fine Tune Divisor
0	Divide delay line/refresh clock further by 30 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 15 μ s refresh period).
1	Divide delay line/refresh clock further by 26 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 13 μs refresh period).
C2, C1, C0	Delay Line/Refresh Clock Divisor Select
0, 0, 0	Divide DELCLK by 10 to get as close to 2 MHz as possible.
0, 0, 1	Divide DELCLK by 9 to get as close to 2 MHz as possible.
0, 1, 0	Divide DELCLK by 8 to get as close to 2 MHz as possible.
0, 1, 1	Divide DELCLK by 7 to get as close to 2 MHz as possible.
1, 0, 0	Divide DELCLK by 6 to get as close to 2 MHz as possible.
1, 0, 1	Divide DELCLK by 5 to get as close to 2 MHz as possible.
1, 1, 0	Divide DELCLK by 4 to get as close to 2 MHz as possible.
1, 1, 1	Divide DELCLK by 3 to get as close to 2 MHz as possible.
R9	Refresh Mode Select
0	$\overline{RAS}0-3$ will all assert and negate at the same time during a refresh.
1	Staggered Refresh. RAS outputs during refresh are separated by one positive clock edge. Depending on the configuration mode chosen, either one or two RASs will be asserted.
R8	Address Pipelining Select
0	Address pipelining is selected. The DRAM controller will switch the DRAM column address back to the row address after guaranteeing the column address hold time.
1	Non-address pipelining is selected. The DRAM controller will hold the column address on the DRAM address bus until the access RASs are negated.
R7	WAIT or DTACK Select
0	WAIT type output is selected.
1	DTACK (Data Transfer ACKnowledge) type output is selected.
R6	Add Wait States to the Current Access if WAITIN is Low
0	WAIT or DTACK will be delayed by one additional positive edge of CLK.
1	WAIT or DTACK will be delayed by two additional positive edges of CLK.

3.0 Programming and Resetting (Continued)

3.3 PROGRAMMING BIT DEFINITIONS (Continued)

Symbol	Description
R5, R4	WAIT/DTACK during Burst (See Section 5.1.2 or 5.2.2)
0, 0	NO WAIT STATES; If $R7 = 0$ during programming, WAIT will remain negated during burst portion of access. If $R7 = 1$ programming, DTACK will remain asserted during burst portion of access.
0, 1	1T; If $R7 = 0$ during programming, WAIT will assert when the ECAS inputs are negated with \overline{AREQ} asserted. WAIT will negate from the positive edge of CLK after the ECASs have been asserted.
	If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted. DTACK will assert from the positive edge of CLK after the ECASs have been asserted.
1, 0	$\frac{1}{2}$ T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated with AREQ asserted. WAIT will negate on the negative level of CLK after the ECASs have been asserted. If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted.
1, 1	DTACK will assert from the negative level of CLK after the ECASs have been asserted. 0T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated. WAIT will negate when
., .	the ECAS inputs are asserted. If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated. DTACK will assert when
	the ECAS inputs are asserted.
R3, R2	WAIT/DTACK Delay Times (See Section 5.1.1 or 5.2.1)
0, 0	NO WAIT STATES; If R7 = 0 during programming, WAIT will remain high during non-delayed accesses. WAIT will negate when RAS is negated during delayed accesses. NO WAIT STATES; If R7 = 1 during programming, DTACK will be asserted when RAS is asserted.
0, 1	$1/_2$ T; If R7 = 0 during programming, WAIT will negate on the negative level of CLK, after the access RAS. 17; If R7 = 1 during programming, DTACK will be asserted on the positive edge of CLK after the access RAS.
1, 0	NO WAIT STATES, $1/2T$; If R7 = 0 during programming, WAIT will remain high during non-delayed accesses. WAIT will negate on the negative level of CLK, after the access RAS, during delayed accesses.
1, 1	1/2T; If R7 = 1 during programming, DTACK will be asserted on the negative level of CLK after the access RAS. 1T; If R7 = 0 during programming, WAIT will negate on the positive edge of CLK after the access RAS. 11/2T; If R7 = 1 during programming, DTACK will be asserted on the negative level of CLK after the positive edge of CLK after the access RAS.
R1, R0	RAS Low and RAS Precharge Time
0, 0	\overrightarrow{RAS} asserted during refresh = 2 positive edges of CLK. \overrightarrow{RAS} precharge time = 1 positive edge of CLK.
0, 1	RAS will start from the first positive edge of CLK after GRANTB transitions (DP8422A). RAS asserted during refresh = 3 positive edges of CLK. RAS precharge time = 2 positive edges of CLK. RAS will start from the second positive edge of CLK after GRANTB transitions (DP8422A).
1, 0	\overline{RAS} asserted during refresh = 2 positive edges of CLK. \overline{RAS} precharge time = 2 positive edges of CLK. \overline{RAS} will start from the first positive edge of CLK after GRANTB transitions (DP8422A).
1, 1	\overline{RAS} asserted during refresh = 4 positive edges of CLK. RAS precharge time = 3 positive edges of CLK.
	RAS will start from the second positive edge of CLK after GRANTB transitions (DP8422A).

4.0 Port A Access Modes

The DP8420A/21A/22A have two general purpose access modes. Mode 0 \overline{RAS} synchronous and Mode 1 \overline{RAS} asynchronous. One of these modes is selected at programming through the B1 input. A Port A access to DRAM is initiated by two input signals: \overline{ADS} (ALE) and \overline{CS} . The access is always terminated by one signal: \overline{AREQ} . These input signals should be synchronous to the input clock.

4.1 ACCESS MODE 0

Mode 0, synchronous access, is selected by negating the input B1 during programming (B1 = 0). To initiate a Mode 0 access, ALE is pulse high and \overline{CS} is asserted. If precharge time was met, a refresh of DRAM or a Port B access was not in progress, the \overline{RAS} (\overline{RASs}) would be asserted on the

first rising edge of clock. If a refresh or a Port B access is in progress or precharge time is required, the controller will wait until these events have taken place and assert $\overline{\text{RAS}}$ ($\overline{\text{RASs}}$) on the next positive edge of clock.

Sometime after the first positive edge of clock after ALE and \overline{CS} have been asserted, the input \overline{AREQ} must be asserted. In single port applications, once \overline{AREQ} is asserted, \overline{CS} can be negated. On the other hand, ALE can stay asserted several periods of clock; however, ALE must be negated before or during the period of CLK in which \overline{AREQ} is negated.

The controller samples $\overline{\text{AREQ}}$ on the every rising edge of clock after $\overline{\text{DTACK}}$ is asserted. The access will end when $\overline{\text{AREQ}}$ is sampled negated.

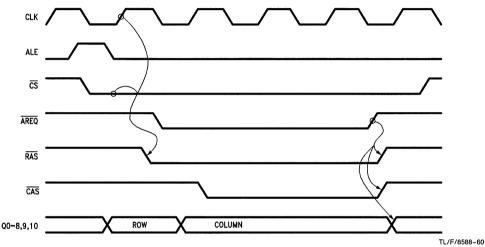


FIGURE 8a. Access Mode 0

4.2 ACCESS MODE 1

Mode 1, asynchronous access, is selected by asserting the input B1 during programming (B1=1). This mode allows accesses to start immediately from the access request input, \overline{ADS} . To initiate a Mode 1 access, \overline{CS} is asserted followed by \overline{ADS} asserted. If precharge time was met, a refresh of the DRAM or a Port B access was not in progress, the \overline{RAS} (\overline{RASs}) would be asserted from \overline{ADS} being asserted. If a refresh or Port B access is in progress or precharge time is required, the controller will wait until these events have tak-

en place and assert $\overline{\text{RAS}}$ ($\overline{\text{RASs}}$) from the next rising edge of clock.

When $\overline{\text{ADS}}$ is asserted or sometime after, $\overline{\text{AREQ}}$ must be asserted. At this time, $\overline{\text{ADS}}$ can be negated and $\overline{\text{AREQ}}$ will continue the access. Also, $\overline{\text{ADS}}$ can continue to be asserted after $\overline{\text{AREQ}}$ has been asserted and negated; however, a new access will not start until $\overline{\text{ADS}}$ is negated and asserted again. When address pipelining is not implemented, $\overline{\text{ADS}}$ and $\overline{\text{AREQ}}$ can be tied together.

The access will end when AREQ is negated.

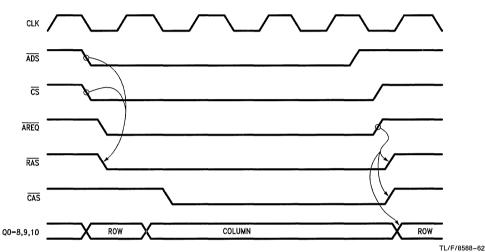
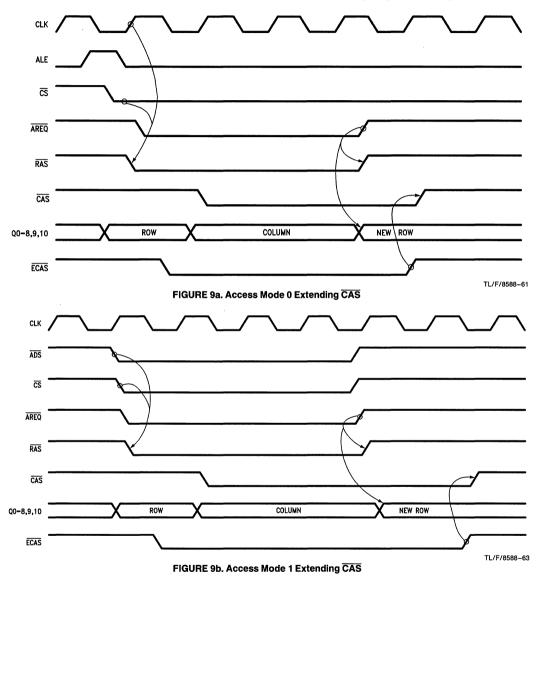


FIGURE 8b. Access Mode 1

4.3 EXTENDING CAS WITH EITHER ACCESS MODE

In both access modes, once \overline{AREQ} is negated, \overline{RAS} and \overline{DTACK} if programmed will be negated. If $\overline{ECAS0}$ was asserted (0) during programming, \overline{CAS} (\overline{CASs}) will be negated

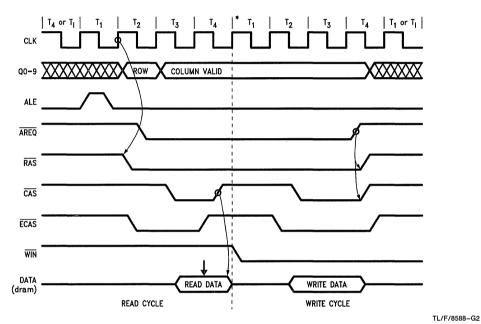
with $\overline{\text{AREO}}$. If $\overline{\text{ECAS0}}$ was negated (1) during programming, $\overline{\text{CAS}}$ ($\overline{\text{CASs}}$) will continue to be asserted after $\overline{\text{RAS}}$ has been negated, given that the appropriate $\overline{\text{ECAS}}$ inputs are asserted. This allows a DRAM to have data present on the data out bus while gaining $\overline{\text{RAS}}$ precharge time.



4.4 READ-MODIFY-WRITE CYCLES WITH EITHER ACCESS MODE

There are 2 methods by which this chip can be used to do read-modify-write access cycles. The first method involves doing a late write access where the $\overline{\text{WIN}}$ input is asserted some delay after $\overline{\text{CAS}}$ is asserted. The second method involves doing a page mode read access followed by a page mode write access with $\overline{\text{HAS}}$ held low (see *Figure 9c*).

CASn must be toggled using the ECASn inputs and WIN has to be changed from negated to asserted (read to write) while CAS is negated. This method is better than changing WIN from negated to asserted in a late write access because here a problem may arise with DATA IN and DATA OUT being valid at the same time. This may result in a data line trying to drive two different levels simultaneously. The page mode method of a read-modify-write access allows the user to have transceivers in the system because the data in (read data) is guaranteed to be high impedance during the time the data out (write data) is valid.



*There may be idle states inserted here by the CPU.

FIGURE 9c. Read-Modify-Write Access Cycle

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4.5 ADDITIONAL ACCESS SUPPORT FEATURES

To support the different modes of accessing, the DP8420A/21A/22A offer other access features. These additional features include: Address Latches and Column Increment (for page/burst mode support), Address Pipelining, and Delay CAS (to allow the user with a multiplexed bus to ensure valid data is present before CAS is asserted).

4.5.1 Address Latches and Column Increment

The Address Latches can be programmed, through programming bit B0. They can be programmed to either latch the address or remain in a fall-through mode. If the address latches are used to latch the address, the controller will function as follows:

In Mode 0, the rising edge of ALE places the latches in fallthrough, once ALE is negated, the address present in the row, column and bank input is latched. In Mode 1, the address latches are in fall through mode until ADS is asserted. ADS asserted latches the address.

Once the address is latched, the column address can be incremented with the input COLINC. COLINC can be used for sequential accesses of static column DRAMs. COLINC can also be used with the ECAS inputs to support sequential accesses to page mode DRAMs as shown in *Figure 10*. COLINC should only be asserted when the signal RFIP is negated during an access since this input functions as extended refresh when RFIP is asserted. COLINC must be negated (0) when the address is being latched ($\overline{\text{ADS}}$ falling edge in Mode 1). If COLINC is asserted with all of the bits of the column address asserted (ones), the column address will return to zero.

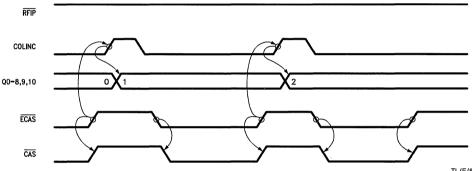


FIGURE 10. Column Increment

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The address latches function differently with the DP8422A. The DP8422A will latch the address of the currently granted port. If Port A is currently granted, the address will be latched as described in Section 4.5.1. If Port A is not granted, and requests an access, the address will be latched on the first or second positive edge of CLK after GRANTB has been negated depending on the programming bits R0, R1. For Port B, if GRANTB is asserted, the address will be latched with $\overline{\text{AREQB}}$ asserted. If GRANTB is negated, the address will latch on the first or second positive edge of CLK after GRANTB is asserted depending on the programming bits R0, R1.

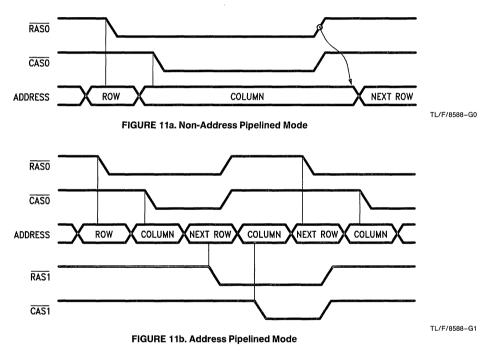
4.5.2 Address Pipelining

Address pipelining is the overlapping of accesses to different banks of DRAM. If the majority of successive accesses are to a different bank, the accesses can be overlapped. Because of this overlapping, the cycle time of the DRAM accesses are greatly reduced. The DP8420A/21A/22A can be programmed to allow a new row address to be placed on the DRAM address bus after the column address hold time has been met. At this time, a new access can be initiated with ADS or ALE, depending on the access mode, while AREQ is used to sustain the current access. The DP8422A supports address pipelining for Port A only. This mode cannot be used with page, static column or nibble modes of operations because the DRAM column address is switched back to the row address after CAS is asserted. This mode is programmed through address bit R8 (see Figures 11a and 11b). In this mode, the output WE always functions as RFRQ.

During address pipelining in Mode 0, shown in *Figure 11c*, ALE cannot be pulsed high to start another access until \overline{AREQ} has been asserted for the previous access for at least one period of CLK. \overline{DTACK} , if programmed, will be negated once \overline{AREQ} is negated. WAIT, if programmed to insert wait states, will be asserted once ALE and \overline{CS} are asserted.

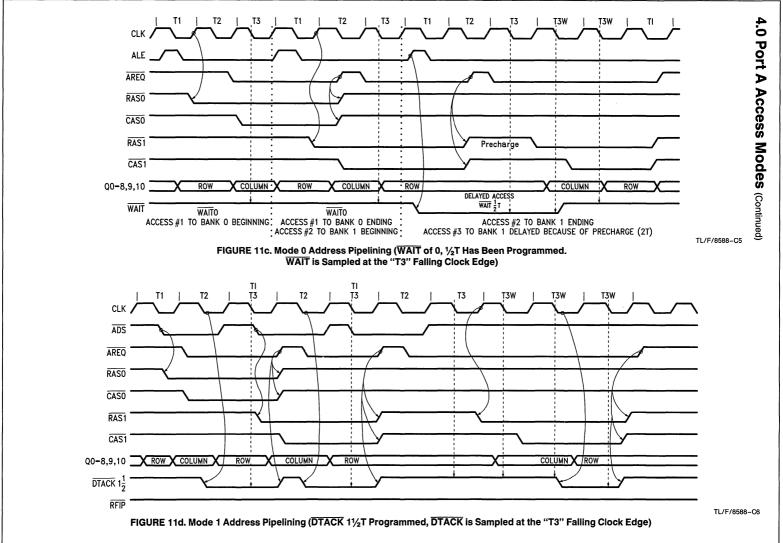
In Mode 1, shown in *Figure 11d*, $\overline{\text{ADS}}$ can be negated once $\overline{\text{AREQ}}$ is asserted. After meeting the minimum negated pulse width for $\overline{\text{ADS}}$, $\overline{\text{ADS}}$ can again be asserted to start a new access. $\overline{\text{DTACK}}$, if programmed, will be negated once $\overline{\text{AREQ}}$ is negated. $\overline{\text{WAIT}}$, if programmed, will be asserted once $\overline{\text{ADS}}$ is asserted.

In either mode with either type of wait programmed, the DP8420A/21A/22A will still delay the access for precharge if sequential accesses are to the same bank or if a refresh takes place.



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DP8420A/DP8421A/DP8422A



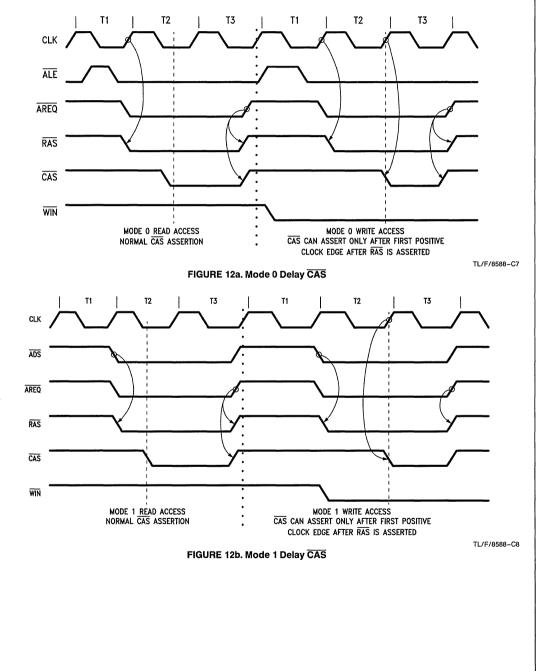
DP8420A/DP8421A/DP8422A

4.0 Port A Access Modes (Continued)

4.5.3 Delay CAS during Write Accesses

Address bit C9 asserted during programming will cause \overline{CAS} to be delayed until the first positive edge of CLK after \overline{RAS} is asserted when the input \overline{WIN} is asserted. Delaying \overline{CAS} during write accesses ensures that the data to be written to DRAM will be setup to \overline{CAS} asserting as shown in *Figures*

12a and 12b. If the possibility exists that data still may not be present after the first positive edge of CLK, \overline{CAS} can be delayed further with the \overline{ECAS} inputs. If address bit C9 is negated during programming, read and write accesses will be treated the same (with regard to \overline{CAS}).



5.0 Refresh Options

The DP8420A/21A/22A support three refresh control mode options:

- 1. Automatic Internally Controlled Refresh.
- 2. Externally Controlled/Burst Refresh.
- 3. Refresh Request/Acknowledge.

With each of the control modes above, three types of refresh can be performed.

- 1. All RAS Refresh.
- 2. Staggered Refresh.
- 3. Error Scrubbing During All RAS Refresh.

There are three inputs, EXTNDRF, $\overrightarrow{\text{RFSH}}$ and $\overrightarrow{\text{DISRFSH}}$, and two outputs, $\overrightarrow{\text{RFIP}}$ and $\overrightarrow{\text{RFRQ}}$, associated with refresh. There are also ten programming bits: $\operatorname{RO-1}$, $\operatorname{R9}$, $\operatorname{CO-6}$ and ECAS0 used to program the various types of refreshing.

Asserting the input EXTNDRF, extends the refresh cycle for a single or multiple integral periods of CLK.

The output $\overline{\text{RFIP}}$ is asserted one period of CLK before the first refresh $\overline{\text{RAS}}$ is asserted. If an access is currently in progress, $\overline{\text{RFIP}}$ will be asserted up to one period of CLK before the first refresh $\overline{\text{RAS}}$, after $\overline{\text{AREQ}}$ or $\overline{\text{AREQB}}$ is negated for the access (see *Figure 13*).

The DP8420A/21A/22A will increment the refresh address counter automatically, independent of the refresh mode used. The refresh address counter will be incremented once all the refresh $\overline{\text{RASs}}$ have been negated.

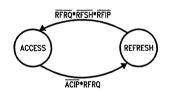
In every combination of refresh control mode and refresh type, the DP8420A/21A/22A is programmed to keep \overline{RAS} asserted a number of CLK periods. The time values of \overline{RAS} low during refresh are programmed through programming bits R0 and R1.

5.1 REFRESH CONTROL MODES

5.1.1. Automatic Internal Refresh

The DP8420A/21A/22A have an internal refresh clock. The period of the refresh clock is generated from the programming bits C0–3. Every period of the refresh clock, an internal refresh request is generated. As long as a DRAM access is not currently in progress and precharge time has been met, the internal refresh request will generate an automatic internal refresh. If a DRAM access is in progress, the DP8420A/21A/22A on-chip arbitration logic will wait until the access arbitration logic can insert a refresh. The refresh/access arbitration logic can insert a refresh cycle between two address pipelined accesses. However, the refresh arbitration logic can not interrupt an access cycle to perform a refresh. To enable automatic internally controlled refreshes, the input DISRFSH must be negated.

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Explanation of Terms

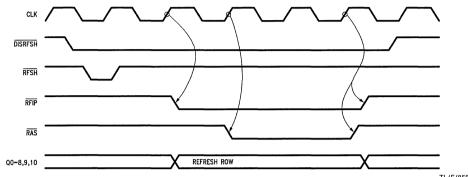
- RFRQ = ReFresh ReQuest internal to the DP8420A/21A/22A. RFRQ has the ability to hold off a pending access.
- RFSH = Externally requested ReFreSH
- RFIP = ReFresh in Progress
- ACIP = Port A or Port B (DP8422A only) ACcess in Progress. This means that either RAS is low for an access or is in the process of transitioning low for an access.

FIGURE 13. DP8420A/21A/22A Access/Refresh Arbitration State Program

5.1.2 Externally Controlled/Burst Refresh

To use externally controlled/burst refresh, the user must disable the automatic internally controlled refreshes by asserting the input $\overline{\text{DISRFSH}}$. The user is responsible for generating the refresh request by asserting the input $\overline{\text{RFSH}}$. Pulsing $\overline{\text{RFSH}}$ low, sets an internal latch, that is used to produce the internal refresh request. The refresh cycle will

take place on the next positive edge of CLK as shown in *Figure 14a*. If an access to DRAM is in progress or precharge time for the last access has not been met, the refresh will be delayed. Since pulsing $\overline{\text{RFSH}}$ low sets a latch, the user does not have to keep $\overline{\text{RFSH}}$ low until the refresh starts. When the last refresh $\overline{\text{RAS}}$ negates, the internal refresh request latch is cleared.

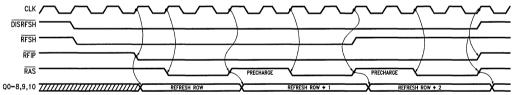






By keeping $\overline{\text{RFSH}}$ asserted past the positive edge of CLK which ends the refresh cycle as shown in *Figure 14b*, the user will perform another refresh cycle. Using this technique, the user can perform a burst refresh consisting of any number of refresh cycles. Each refresh cycle during a burst refresh will meet the refresh $\overline{\text{RAS}}$ low time and the $\overline{\text{RAS}}$ precharge time (programming bits R0–1).

If the user desires to burst refresh the entire DRAM (all row addresses) he could generate an end of count signal (burst refresh finished) by looking at one of the DP8420A/21A/22A high address outputs (Q7, Q8, Q9 or Q10) and the RFIP output. The Qn outputs function as a decode of how many row addresses have been refreshed (Q7 = 128 refreshes, Q8 = 256 refreshes, Q9 = 512 refreshes), Q10 = 1024 refreshes).



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FIGURE 14b. External Burst Refresh (2 Periods of RAS Precharge, 2 Periods of Refresh RAS Low during Refresh Programmed)

5.1.3 Refresh Request/Acknowledge

The DP8420A/21A/22A can be programmed to output internal refresh requests. When the user programs ECASO negated (1) and/or address pipelining mode is selected, the WE output functions as RFRQ. RFRQ (WE) will be asserted by one of two events:

First, when the external circuitry pulses low the input RFSH which will request an external refresh.

Second, when the internal refresh clock has expired, which signals that another refresh is needed.

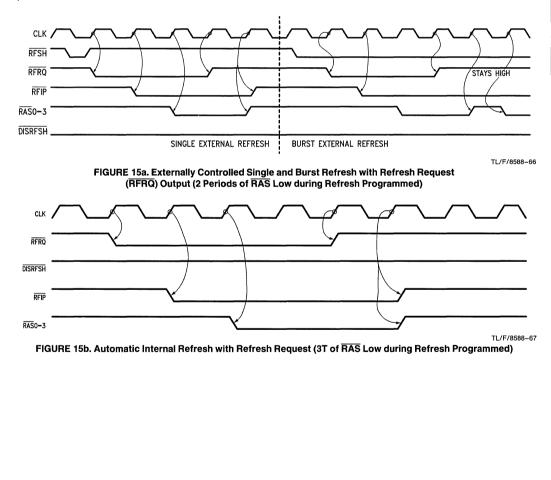
An example of the first case, where an external refresh is requested while $\overline{\text{RFRQ}}$ is negated (1), is shown in *Figure 15a*. Notice that $\overline{\text{RFRQ}}$ will be asserted from a positive edge of clock.

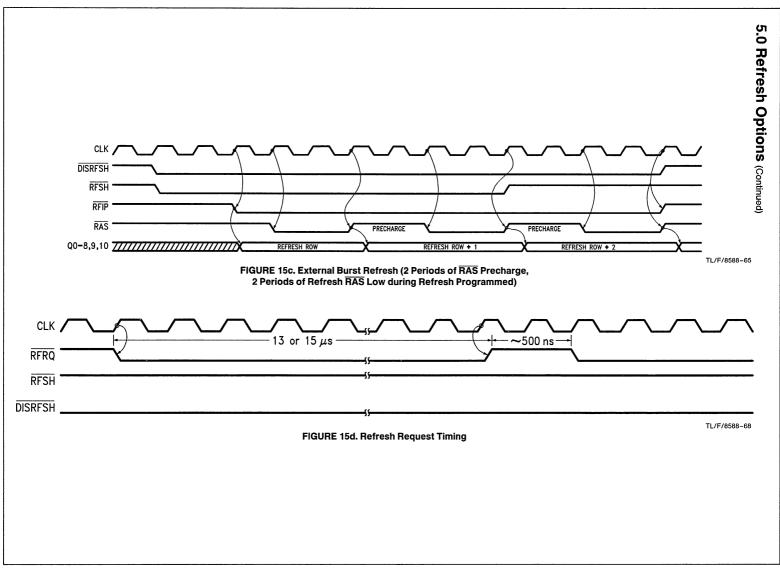
On the second case, when the RFRQ is asserted from the expiration of the internal refresh clock, the user has two options:

First, if DISRFSH is negated, an automatic internal refresh will take place. See *Figure 15b*.

Second, with DISRFSH asserted, RFRQ will stay asserted until RFSH is pulsed low. This option will cause an externally requested/burst refresh to take place. See *Figure 15c*.

RFRQ will go high and then assert (toggle) if additional periods of the internal refresh clock have expired and neither an externally controlled refresh nor an automatically controlled internal refresh have taken place, see *Figure 15d*. If a time critical event, or long accesses like page/static column mode can not be interrupted, RFRQ pulsing high can be used to increment a counter. This counter can be used to perform a burst refresh of the number of refreshes missed (through the RFSH input).





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5.2 REFRESH CYCLE TYPES

Three different types of refresh cycles are available for use. The three different types are mutually exclusive and can be used with any of the three modes of refresh control. The three different refresh cycle types are: all RAS refresh, staggered RAS refresh and error scrubbing during all RAS refresh. In all refresh cycle types, the RAS precharge time is guaranteed: between the previous access RAS ending and the refresh RAS0 starting; between refresh RAS3 ending and and access RAS0 beginning; between burst refresh RAS3.

5.2.1 Conventional RAS Refresh

A conventional refresh cycle causes $\overline{RAS0-3}$ to all assert from the first positive edge of CLK after \overline{RFIP} is asserted as shown in *Figure 16*. $\overline{RAS0-3}$ will stay asserted until the number of positive edges of CLK programmed have passed. On the last positive edge, $\overline{RAS0-3}$, and \overline{RFIP} will be negated. This type of refresh cycle is programmed by negating address bit R9 during programming.

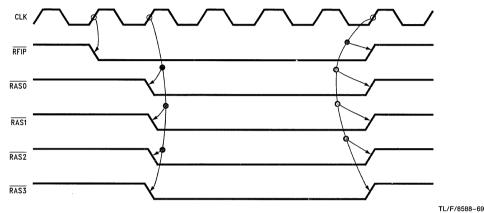
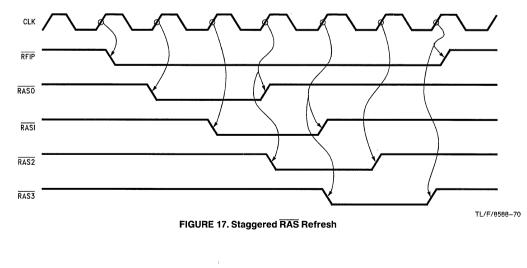


FIGURE 16. Conventional RAS Refresh

5.2.2 Staggered RAS Refresh

A staggered refresh staggers each $\overline{\text{RAS}}$ or group of $\overline{\text{RASs}}$ by a positive edge of CLK as shown in *Figure 17*. The number of $\overline{\text{RASs}}$, which will be asserted on each positive edge of CLK, is determined by the $\overline{\text{RAS}}$ ($\overline{\text{CAS}}$ configuration mode programming bits C4–C6. If single $\overline{\text{RAS}}$ outputs are selected during programming, then each $\overline{\text{RAS}}$ will assert on successive positive edges of CLK. If two $\overline{\text{RAS}}$ outputs are selected during programming then $\overline{\text{RAS}}$ on $\overline{\text{RAS}}$ in will assert

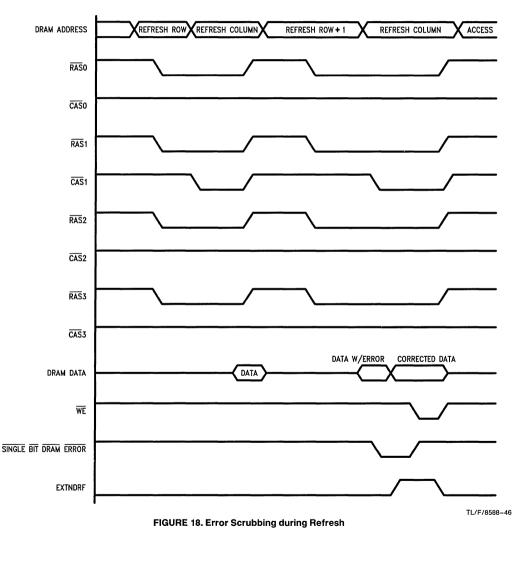
on the first positive edge of CLK after RFIP is asserted. RAS2 and RAS3 will assert on the second positive edge of CLK after RFIP is asserted. If all RAS outputs were selected during programming, all RAS outputs would assert on the first positive edge of CLK after RFIP is asserted. Each RAS or group of RASS will meet the programmed RAS low time and then negate.



5.2.3 Error Scrubbing during Refresh

The DP8420A/21A/22A support error scrubbing during all RAS DRAM refreshes. Error scrubbing during refresh is selected through bits C4–C6 with bit R9 negated during programming. Error scrubbing can not be used with staggered refresh (see Section 8.0). Error scrubbing during refresh allows a CAS or group of CASs to assert during the all RAS refresh as shown in *Figure 18*. This allows data to be read from the DRAM array and passed through an Error Detection And Correction Chip, EDAC. If the EDAC determines that the data contains a single bit error and corrects that error, the refresh cycle can be extended with the input ex-

tend refresh, EXTNDRF, and a read-modify-write operation can be performed by asserting WE. It is the responsibility of the designer to ensure that WE is negated. The DP8422A has a 24-bit internal refresh address counter that contains the 11 row, 11 column and 2 bank addresses. The DP8420A/21A have a 22-bit internal refresh address counter that contains the 10 row, 10 column and 2 bank addresses. These counters are configured as bank, column, row with the row address as the least significant bits. The bank counter bits are then used with the programming selection to determine which \overline{CAS} or group of \overline{CASs} will assert during a refresh.



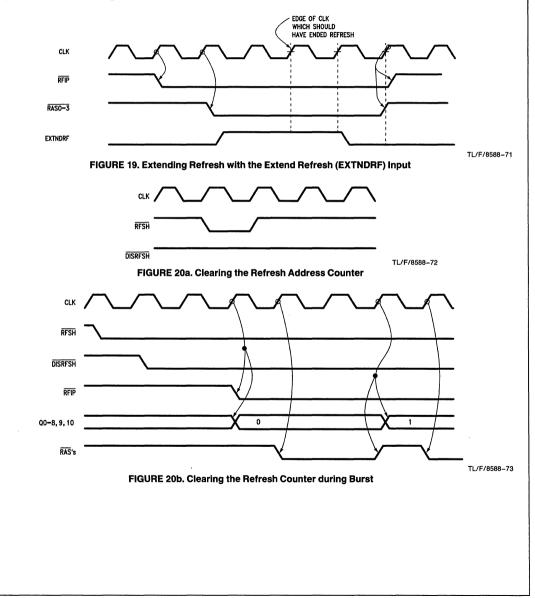
5.3 EXTENDING REFRESH

The programmed number of periods of CLK that refresh RASs are asserted can be extended by one or multiple periods of CLK. Only the all RAS (with or without error scrubbing) type of refresh can be extended. To extend a refresh cycle, the input extend refresh, EXTNDRF, must be asserted before the positive edge of CLK that would have negated all the RAS outputs during the refresh cycle and after the positive edge of CLK which starts all RAS outputs during the refresh as shown in *Figure 19*. This will extend the refresh to the next positive edge of CLK and EXTNDRF will be sampled again. The refresh cycle will continue until EXTNDRF is sampled low on a positive edge of CLK.

5.4 CLEARING THE REFRESH ADDRESS COUNTER

The refresh address counter can be cleared by asserting RFSH while DISRFSH is negated as shown in *Figure 20a*.

This can be used prior to a burst refresh of the entire memory array. By asserting $\overrightarrow{\text{RFSH}}$ one period of CLK before $\overrightarrow{\text{DISRFSH}}$ is asserted and then keeping both inputs asserted, the DP8420A/21A/22A will clear the refresh address counter and then perform refresh cycles separated by the programmed value of precharge as shown in *Figure 20b*. An end-of-count signal can be generated from the Q DRAM address outputs of the DP8420A/21A/22A and used to negate $\overrightarrow{\text{RFSH}}$.



5.5 CLEARING THE REFRESH REQUEST CLOCK

The refresh request clock can be cleared by negating DISRFSH and asserting RFSH for 500 ns, one period of the internal 2 MHz clock as shown in *Figure 21*. By clearing the

refresh request clock, the user is guaranteed that an internal refresh request will not be generated for approximately 15 μ s, one refresh clock period, from the time RFSH is negated. This action will also clear the refresh address counter.

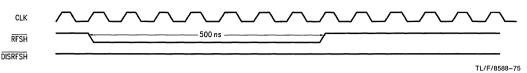


FIGURE 21. Clearing the Refresh Request Clock Counter

6.0 Port A Wait State Support

Wait states allow a CPU's access cycle to be increased by one or multiple CPU clock periods. The wait or ready input is named differently by CPU manufacturers. However, any CPU's wait or ready input is compatible with either the WAIT or DTACK output of the DP8420A/21A/22A. The user determines whether to program WAIT or DTACK (R7) and which value to select for WAIT or DTACK (R2, R3) depending upon the CPU used and where the CPU samples its wait input during an access cycle.

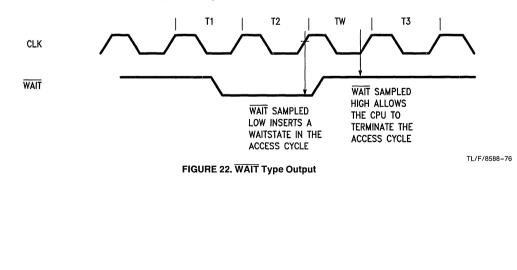
The decision to terminate the CPU access cycle is directly affected by the speed of the DRAMs used. The system designer must ensure that the data from the DRAMs will be present for the CPU to sample or that the data has been written to the DRAM before allowing the CPU access cycle to terminate.

The insertion of wait states also allows a CPU's access cycle to be extended until the DRAM access has taken place. The DP8420A/21A/22A insert wait states into CPU access cycles due to; guaranteeing precharge time, refresh currently in progress, user programmed wait states, the WAITIN signal being asserted and GRANTB not being valid (DP8422A only). If one of these events is taking place and the CPU starts an access, the DP8420A/21A/22A will insert wait states into the access cycle, thereby increasing the length of the CPU's access. Once the event has been completed, the DP8420A/21A/22A will allow the access to take place and stop inserting wait states.

There are six programming bits, R2–R7; an input, WAITIN; and an output that functions as WAIT or DTACK.

6.1 WAIT TYPE OUTPUT

With the R7 address bit negated during programming, the user selects the WAIT output. As long as WAIT is sampled asserted by the CPU, wait states (extra clock periods) are inserted into the current access cycle as shown in Figure 22. Once \overline{WAIT} is sampled negated, the access cycle is completed by the CPU. WAIT is asserted at the beginning of a chip selected access and is programmed to negate a number of positive edges and/or negative levels of CLK from the event that starts the access. WAIT can also be programmed to function in page/burst mode applications. Once WAIT is negated during an access, and the ECAS inputs are negated with AREQ asserted, WAIT can be programmed to toggle, following the ECAS inputs. Once AREQ is negated, ending the access, WAIT will stay negated until the next chip selected access. For more details about WAIT Type Output, see Application Note AN-773.



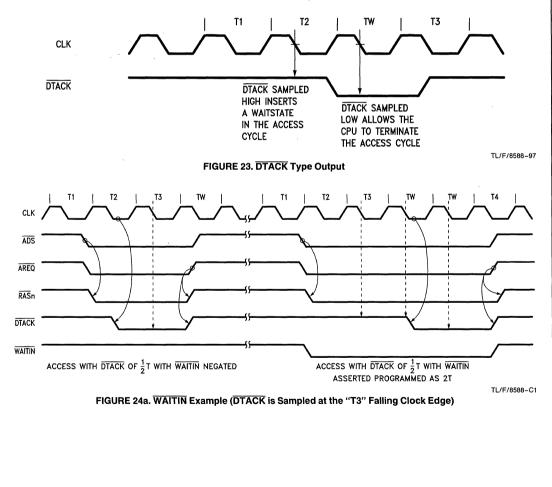
6.0 Port A Wait State Support (Continued)

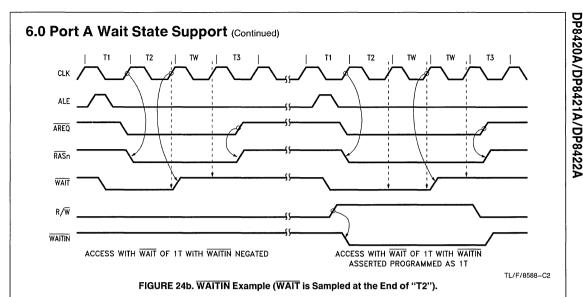
6.2 DTACK TYPE OUTPUT

With the R7 address bit asserted during programming, the user selects the DTACK type output. As long as DTACK is sampled negated by the CPU, wait states are inserted into the current access cycle as shown in Figure 23. Once DTACK is sampled asserted, the access cycle is completed by the CPU. DTACK, which is normally negated, is programmed to assert a number of positive edges and/or negative levels from the event that starts RAS for the access. DTACK can also be programmed to function during page/ burst mode accesses. Once DTACK is asserted and the ECAS inputs are negated with AREQ asserted. DTACK can be programmed to negate and assert from the ECAS inputs toggling to perform a page/burst mode operation. Once AREQ is negated, ending the access, DTACK will be negated and stavs negated until the next chip selected access. For more details about DTACK type output see Application Note AN-773.

6.3 DYNAMICALLY INCREASING THE NUMBER OF WAIT STATES

The user can increase the number of positive edges of CLK before DTACK is asserted or WAIT is negated. With the input WAITIN asserted, the user can delay DTACK asserting or WAIT negating either one or two more positive edges of CLK. The number of edges is programmed through address bit R6. If the user is increasing the number of positive edges in a delay that contains a negative level, the positive edges will be met before the negative level. For example if the user programmed DTACK of 1/2T, asserting WAITIN, programmed as 2T, would increase the number of positive edges resulting in DTACK of 21/3T as shown in Figure 24a. Similarly. WAITIN can increase the number of positive edges in a page/burst access. WAITIN can be permanently asserted in systems requiring an increased number of wait states. WAITIN can also be asserted and negated, depending on the type of access. As an example, a user could invert the WRITE line from the CPU and connect the output to WAITIN. This could be used to perform write accesses with 1 wait state and read accesses with 2 wait states as shown in Figure 24b.





6.4 GUARANTEEING RAS LOW TIME AND RAS PRECHARGE TIME

The DP8420A/21A/22A will guarantee $\overline{\text{RAS}}$ precharge time between accesses; between refreshes; and between access and refreshes. The programming bits R0 and R1 are used to program combinations of $\overline{\text{RAS}}$ precharge time and $\overline{\text{RAS}}$ low time referenced by positive edges of CLK. $\overline{\text{RAS}}$ low time is programmed for refreshes only. During an access, the system designer guarantees the time $\overline{\text{RAS}}$ is asserted through the DP8420A/21A/22A wait logic. Since inserting wait states into an access increases the length of the CPU signals which are used to create $\overline{\text{ADS}}$ or ALE and $\overline{\text{AREQ}}$, the time that $\overline{\text{RAS}}$ is asserted can be guaranteed.

The precharge time is also guaranteed by the DP8420A/21A/22A. Each $\overline{\text{RAS}}$ output has a separate posi-

tive edge of CLK counter. $\overline{\text{AREQ}}$ is negated setup to a positive edge of CLK to terminate the access. That positive edge is 1T. The next positive edge is 2T. $\overline{\text{RAS}}$ will not be asserted until the programmed number of positive edges of CLK have passed as shown in *Figure 25*. Once the programmed precharge time has been met, $\overline{\text{RAS}}$ will be asserted from the positive edge of CLK. However, since there is a precharge counter per $\overline{\text{RAS}}$, an access using another $\overline{\text{RAS}}$ will not be delayed. Precharge time before a refresh is always referenced from the access $\overline{\text{RAS}}$ negating before $\overline{\text{RAS}}$ of the refresh asserting. After a refresh, precharge time is referenced from $\overline{\text{RAS}}$ angating, for the refresh, to the access $\overline{\text{RAS}}$ asserting.

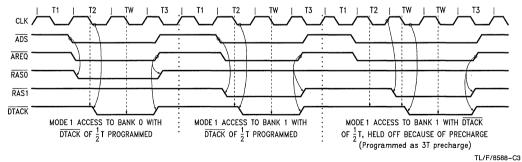


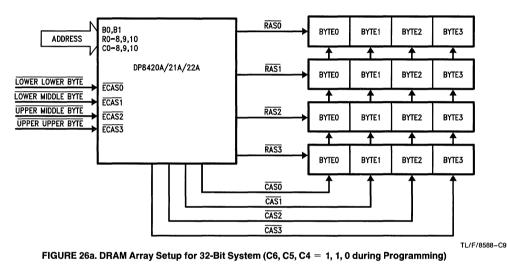
FIGURE 25. Guaranteeing RAS Precharge (DTACK is Sampled at the "T2" Falling Clock Edge)

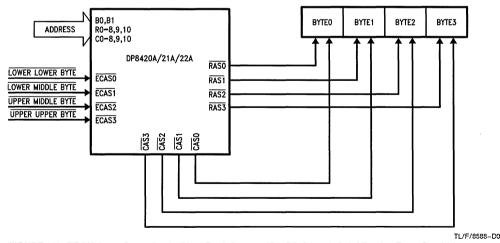
7.0 RAS and CAS Configuration Modes

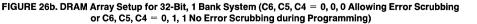
The DP8420A/21A/22A allow the user to configure the DRAM array to contain one, two or four banks of DRAM. Depending on the functions used, certain considerations must be used when determining how to set up the DRAM array. Programming address bits C4, C5 and C6 along with bank selects, BO-1, and \overline{CAS} enables, $\overline{ECASO}-3$, determine which \overline{RAS} or group of \overline{RASs} and which \overline{CAS} or group of \overline{CASs} will be asserted during an access. Different memory schemes are described. The DP8420A/21A/22A is specified driving a heavy load of 72 DRAMs, representing four banks of DRAM with 16-bit words and 2 parity bits. The DP8420A/21A/22A can drive more than 72 DRAMs, but the AC timing must be increased. Since the \overline{RAS} outputs should be used for the maximum amount of drive.

7.1 BYTE WRITING

By selecting a configuration in which all \overrightarrow{CAS} outputs are selected during an access, the \overrightarrow{ECAS} inputs enable a single or group of \overrightarrow{CAS} outputs to select a byte (or bytes) in a word size of up to 32 bits. In this case, the \overrightarrow{RAS} outputs are used to select which of up to 4 banks is to be used as shown in *Figures 26a* and *26b*. In systems with a word size of 16 bits, the byte enables can be gated with a high order address bit to produce four byte enables which gives an equivalent to 8 banks of 16-bit words as shown in *Figure 26d*. If less memory is required, each \overrightarrow{CAS} should be used to drive each nibble in the 16-bit word as shown in *Figure 26c*.







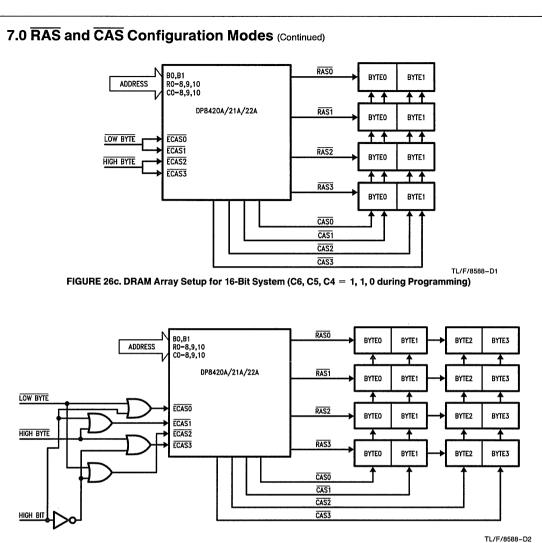


FIGURE 26d. 8 Bank DRAM Array for 16-Bit System (C6, C5, C4 = 1, 1, 0 during Programming)

DP8420A/DP8421A/DP8422A

DP8420A/DP8421A/DP8422A

7.0 RAS and CAS Configuration Modes (Continued)

7.2 MEMORY INTERLEAVING

Memory interleaving allows the cycle time of DRAMs to be reduced by having sequential accesses to different memory banks. Since the DP8420A/21A/22A have separate precharge counters per bank, sequential accesses will not be delayed if the accessed banks use different RAS outputs. To ensure different RAS outputs will be used, a mode is selected where either one or two RAS outputs will be asserted during an access. The bank select or selects, B0 and B1, are then tied to the least significant address bits, causing a different group of RASs to assert during each sequential access as shown in *Figure 27*. In this figure there should be at least one clock period of all RAS's negated between different RAS's being asserted to avoid the condition of a CAS before RAS refresh cycle.

7.3 ADDRESS PIPELINING

Address pipelining allows several access RASs to be asserted at once. Because RASs can overlap, each bank requires either a mode where one RAS and one CAS are used per bank as shown in Figure 28a or where two RASs and two CASs are used per bank as shown in Figure 28b. Byte writing can be accomplished in a 16-bit word system if two RASs and two CASs are used per bank. In other systems, WEs (or external gating on the CAS outputs) must be used to perform byte writing. If WEs are used separate data in and data out buffers must be used. If the array is not layed out this way, a CAS to a bank can be low before RAS, which will cause a refresh of the DRAM, not an access. To take full advantage of address pipelining, memory interleaving is used. To memory interleave, the least significant address bits should be tied to the bank select inputs to ensure that all "back to back" sequential accesses are not delayed. since different memory banks are accessed.

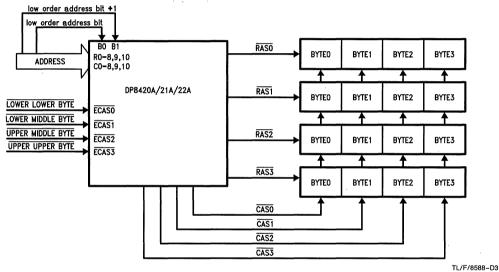
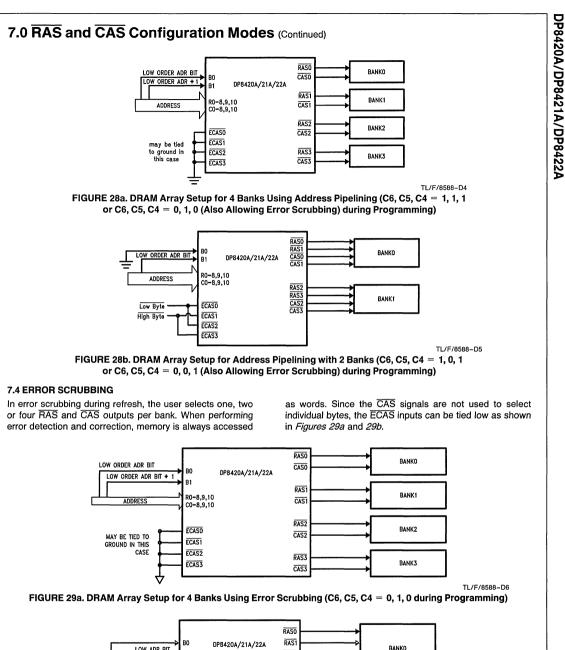


FIGURE 27. Memory Interleaving (C6, C5, C4 = 1, 1, 0 during Programming)



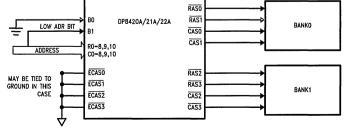


FIGURE 29b. DRAM Array Setup for Error Scrubbing with 2 Banks (C6, C5, C4 = 0, 0, 1 during Programming)

1

TL/F/8588-D7

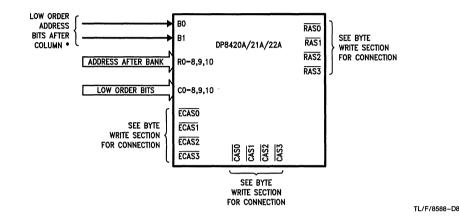
DP8420A/DP8421A/DP8422A

7.0 RAS and CAS Configuration Modes (Continued)

7.5 PAGE/BURST MODE

In a static column, page or burst mode system, the least significant bits must be tied to the column address in order to ensure that the page/burst accesses are to sequential memory addresses, as shown in *Figure 30*. In a nibble mode system, the least significant bits must be tied to the highest column and row address bits in order to ensure that sequential address bits are the "nibble" bits for nibble mode accesses (*Figure 30*). The ECAS inputs may then be tog-

gled with the DP8420A/21A/22A's address latches in fallthrough mode, while \overline{AREQ} is asserted. The ECAS inputs can also be used to select individual bytes. When using nibble mode DRAMS, the third and fourth address bits can be tied to the bank select inputs to perform memory interleaving. In page or static column modes, the two address bits after the page size can be tied to the bank select inputs to select a new bank if the page size is exceeded.



*See table below for row, column & bank address bit map. A0, A1 are used for byte addressing in this example.

Addresses	Nibble Mode*	Page Mode/Static Column Mode Page Size				
Audicosco		256 Bits/Page	512 Bits/Page	1024 Bits/Page	2048 Bits/Page	
Column Address	C9,R9 = A2,A3 C0-8 = X	C0-7 = A2-9 C8-10 = X	C0-8 = A2-10 C9,10 = X	C0-9 = A2-11 C10 = X	C0-10 = A2-12	
Row Address	×	x	x	x	x	
B0 B1	A4 A5	A10 A11	A11 A12	A12 A13	A13 A14	

Assume that the least significant address bits are used for byte addressing. Given a 32-bit system A0,A1 would be used for byte addressing.

X = DON'T CARE, the user can do as he pleases.

*Nibble mode values for R and C assume a system using 1 Mbit DRAMs.

FIGURE 30. Page, Static Column, Nibble Mode System

8.0 Test Mode

Staggered refresh in combination with the error scrubbing mode places the DP8420A/21A/22A in test mode. In this mode, the 24-bit refresh counter is divided into a 13-bit and 11-bit counter. During refreshes both counters are incremented to reduce test time.

9.0 DRAM Critical Timing Parameters

The two critical timing parameters, shown in *Figure 31*, that must be met when controlling the access timing to a DRAM are the row address hold time, t_{RAH} , and the column address setup time, t_{ASC} . Since the DP8420A/21A/22A contain a precise internal delay line, the values of these parameters can be selected at programming time. These values will also increase and decrease if DELCLK varies from 2 MHz.

9.1 PROGRAMMABLE VALUES OF tRAH AND TASC

The DP8420A/21A/22A allow the values of t_{RAH} and t_{ASC} to be selected at programming time. For each parameter, two choices can be selected. t_{RAH} , the row address hold time, is measured from RAS asserted to the row address starting to change to the column address. The two choices for t_{RAH} are 15 ns and 25 ns, programmable through address bit C8.

 t_{ASC} , the column address setup time, is measured from the column address valid to \overline{CAS} asserted. The two choices for t_{ASC} are 0 ns and 10 ns, programmable through address bit C7.

9.2 CALCULATION OF tRAH AND TASC

There are two clock inputs to the DP8420A/21A/22A. These two clocks, DELCLK and CLK can either be tied together to the same clock or be tied to different clocks running asynchronously at different frequencies.

The clock input, DELCLK, controls the internal delay line and refresh request clock. DELCLK should be a multiple of 2 MHz. If DELCLK is not a multiple of 2 MHz, t_{RAH} and t_{ASC} will change. The new values of t_{RAH} and t_{ASC} can be calculated by the following formulas:

If t_{RAH} was programmed to equal 15 ns then $t_{RAH} = 30^{*}(((DELCLK Divisor)^{*} 2 MHz/(DELCLK Frequency)) - 1) + 15 ns.$

If t_{RAH} was programmed to equal 25 ns then $t_{RAH} = 30^{*}(((DELCLK Divisor)^{*} 2 MHz/(DELCLK Frequency)) - 1) + 25 ns.$

If t_{ASC} was programmed to equal 0 ns then $t_{ASC} = 15^*$ ((DELCLK Divisor)* 2 MHz/(DELCLK Frequency)) - 15 ns. If t_{ASC} was programmed to equal 10 ns then $t_{ASC} = 25^*$ ((DELCLK Divisor)* 2 MHz/(DELCLK Frequency)) - 15 ns. Since the values of t_{RAH} and t_{ASC} are increased or decreased, the time to CAS asserted will also increase or decrease. These parameters can be adjusted by the following formula:

 $\begin{array}{l} \mbox{Delay to } \overline{\mbox{CAS}} = \mbox{Actual Spec.} + \mbox{Actual t}_{RAH} - \\ \mbox{Programmed t}_{RAH} + \mbox{Actual t}_{ASC} - \mbox{Programmed t}_{ASC}. \end{array}$

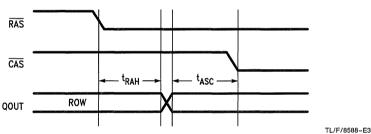


FIGURE 31. t_{RAH} and t_{ASC}

1

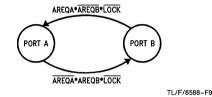
10.0 Dual Accessing (DP8422A)

The DP8422A has all the functions previously described. In addition to those features, the DP8422A also has the capabilities to arbitrate among refresh, Port A and a second port, Port B. This allows two CPUs to access a common DRAM array. DRAM refresh has the highest priority followed by the currently granted port. The ungranted port has the lowest priority. The last granted port will continue to stay granted even after the access has terminated, until an access request is received from the ungranted port (see *Figure 32a*). The dual access configuration assumes that both Port A and Port B are synchronous to the system clock. If they are not synchronoized (Ex. By running the access requests through several Flip-Flops, see *Figure 34a*).

10.1 PORT B ACCESS MODE

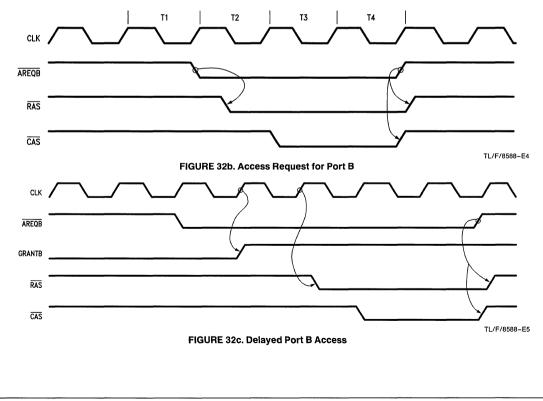
Port B accesses are initiated from a single input, AREQB. When AREQB is asserted, an access request is generated. If GRANTB is asserted and a refresh is not taking place or precharge time is not required, RAS will be asserted when AREQB is asserted. Once AREQB is asserted, it must stay asserted until the access is over. AREQB negated, negates RAS as shown in *Figure 32b*. Note that if ECAS0 = 1 during programming the CAS outputs may be held asserted (beyond RASn negating) by continuing to assert the appropriate ECASn inputs (the same as Port A accesses). If Port B is not granted, the access will begin on the first or second positive edge of CLK after GRANTB is asserted (See R0, R1 programming that Port A is not accessing the DRAM (CS, ADS/ ALE and AREQ) and RAS precharge for the particular bank has completed. It is important to note that for GRANTB to transition to Port B, Port A must **not** be requesting an access at a rising clock edge (or locked) and Port B must be requesting an access at that rising clock edge. Port A can request an access through \overline{CS} and \overline{ADS}/ALE or \overline{CS} and \overline{ADS}/ALE or \overline{CS} and \overline{ADS}/ALE observe asserted before \overline{AREQ} from the previous access is negated, Port A will retain GRANTB = 0 whether \overline{AREQB} is asserted or not.

Since there is no chip select for Port B, AREQB must incorporate this signal. This mode of accessing is similar to Mode 1 accessing for Port A.



Explanation of Terms

Explanation	or remis
AREQA =	Chip Selected access request from Port A
AREQB =	Chip Selected access request from Port B
LOCK =	Externally controlled LOCKing of the Port that is currently GRANTed.
FIGU	IRE 32a. DP8422A Port A/Port B Arbitration
Stat	e Diagram. This arbitration may take place
	during the "ACCESS" or "REFRESH"
	state (see <i>Figure 13a</i>).



10.0 Dual Accessing (DP8422A) (Continued)

10.2 PORT B WAIT STATE SUPPORT

Advanced transfer acknowledge for Port B, ATACKB, is used for wait state support for Port B. This output will be asserted when RAS for the Port B access is asserted, as shown in *Figures 33a* and *33b*. Once asserted, this output will stay asserted until AREQB is negated. With external logic, ATACKB can be made to interface to any CPU's wait input as shown in *Figure 33c*.

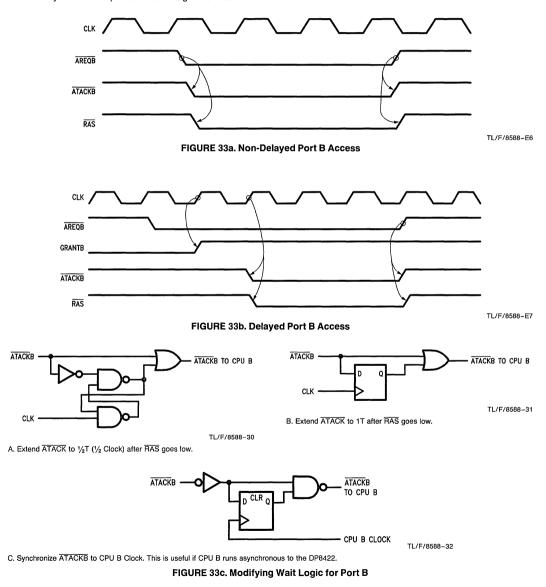
10.3 COMMON PORT A AND PORT B DUAL PORT FUNCTIONS

An input, LOCK, and an output, GRANTB, add additional functionality to the dual port arbitration logic. LOCK allows

Port A or Port B to lock out the other port from the DRAM. When a Port is locked out of the DRAM, wait states will be inserted into its access cycle until it is allowed to access memory. GRANTB is used to multiplex the input control signals and addresses to the DP8422A.

10.3.1 GRANTB Output

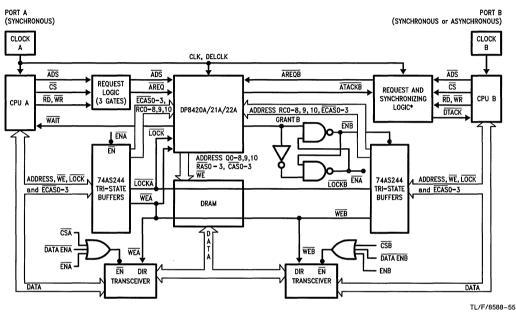
The output GRANTB determines which port has current access to the DRAM array. GRANTB asserted signifies Port B has access. GRANTB negated signifies Port A has access to the DRAM array.



10.0 Dual Accessing (DP8422A) (Continued)

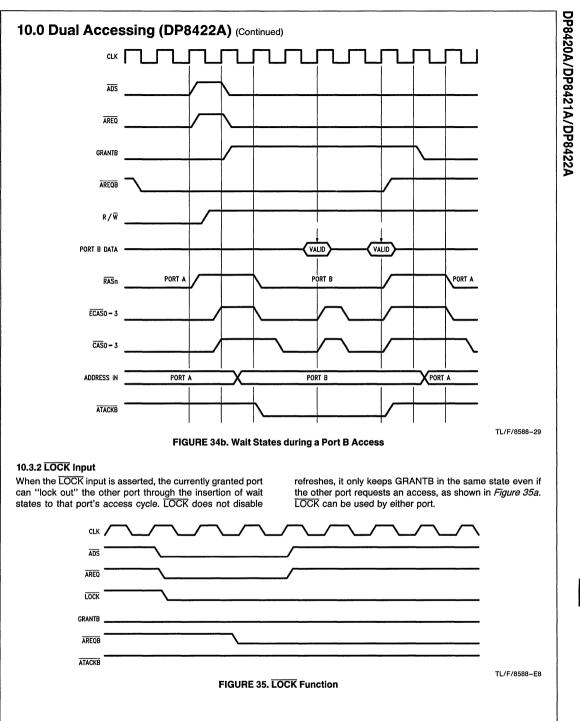
Since the DP8422A has only one set of address inputs, the signal is used, with the addition of buffers, to allow the currently granted port's addresses to reach the DP8422A. The signals which need to be bufferred are R0–10, C0–10, B0–1, ECAS0–3, WE, and LOCK. All other inputs are not common and do not have to be buffered as shown in *Figure 34a*. If a Port, which is not currently granted, tries to access

the DRAM array, the GRANTB output will transition from a rising clock edge from \overline{AREQ} or \overline{AREQB} negating and will precede the \overline{RAS} for the access by one or two clock periods. GRANTB will then stay in this state until the other port requests an access and the currently granted port is not accessing the DRAM as shown in *Figure 34b*.



*If Port B is synchronous the Request Synchronizing logic will not be required.

FIGURE 34a. Dual Accessing with the DP8422A (System Block Diagram)



×1.4

11.0 Absolute Maximum Ratings (Note 1)

 Temperature under Bias $\dots 0^{\circ}$ C to $+ 70^{\circ}$ C Storage Temperature $\dots -65^{\circ}$ C to $+ 150^{\circ}$ C ESD Rating to be determined.

12.0 DC Electrical Characteristics $T_A = 0^{\circ}C \text{ to } + 70^{\circ}C$, $V_{CC} = 5V \pm 10^{\circ}$, GND = 0V

Symbol	Parameter	Conditions	Min	Тур	Max	Units
VIH	Logical 1 Input Voltage	Tested with a Limited Functional Pattern	2.0		V _{CC} + 0.5	v
VIL	Logical 0 Input Voltage	Tested with a Limited Functional Pattern	-0.5		0.8	v
V _{OH1}	Q and WE Outputs	$I_{OH} = -10 \text{ mA}$	V _{CC} - 1.0			v
V _{OL1}	Q and WE Outputs	l _{OL} = 10 mA			0.5	v
V _{OH2}	All Outputs except Qs, WE	$I_{OH} = -3 \text{ mA}$	V _{CC} - 1.0			V
V _{OL2}	All Outputs except Qs, WE	$I_{OL} = 3 \text{ mA}$			0.5	V
I _{IN}	Input Leakage Current	$V_{IN} = V_{CC} \text{ or } GND$	-10		10	μΑ
	ML Input Current (Low)	V _{IN} = GND			200	μΑ
I _{CC1}	Standby Current	CLK at 8 MHz ($V_{IN} = V_{CC}$ or GND)		6	15	mA
ICC1	Standby Current	CLK at 20 MHz ($V_{IN} = V_{CC}$ or GND)		8	17	mA
ICC1	Standby Current	CLK at 25 MHz (V _{IN} = V _{CC} or GND)		10	20	mA
I _{CC2}	Supply Current	CLK at 8 MHz (Inputs Active) ($I_{LOAD} = 0$) ($V_{IN} = V_{CC}$ or GND)		20	40	mA
I _{CC2}	Supply Current	CLK at 20 MHz (Inputs Active) $(I_{LOAD} = 0) (V_{IN} = V_{CC} \text{ or GND})$		40	75	mA
I _{CC2}	Supply Current	CLK at 25 MHz (Inputs Active) ($I_{LOAD} = 0$) ($V_{IN} = V_{CC}$ or GND)		50	95	mA
C _{IN} *	Input Capacitance	f _{IN} at 1 MHz			10	pF

*CIN is not 100% tested.

13.0 AC Timing Parameters

Two speed selections are given, the DP8420A/21A/22A-20 and the DP8420A/21A/22A-25. The differences between the two parts are the maximum operating frequencies of the input CLKs and the maximum delay specifications. Low frequency applications may use the "-25" part to gain improved timing.

The AC timing parameters are grouped into sectional numbers as shown below. These numbers also refer to the timing diagrams.

1-36 Common parameters to all modes of operation

50–56 Difference parameters used to calculate; RAS low time,

RAS precharge time, CAS high time and

 $\overline{\text{CAS}}$ low time

- 100–121 Common dual access parameters used for Port B accesses and inputs and outputs used only in dual accessing
- 200-212 Refresh parameters

- 300-315 Mode 0 access parameters used in both single and dual access applications
- 400-416 Mode 1 access parameters used in both single and dual access applications
- 450-455 Special Mode 1 access parameters which supersede the 400-416 parameters when dual accessing

500-506 Programming parameters

Unless otherwise stated $V_{CC}=5.0V\pm10\%,\,0< T_A<70^\circ C,$ the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$ loads on all outputs except
- $C_L=~150~pF$ loads on Q0–8, 9, 10 and $\overline{WE};$ or
- $C_H = 50 \text{ pF}$ loads on all outputs except
- $C_{H}=~125~pF$ loads on $\overline{RAS}0{-}3$ and $\overline{CAS}0{-}3$ and
- $C_{\text{H}}=~380$ pF loads on Q0–8, 9, 10 and $\overline{\text{WE}}.$

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation. Note 2: Input pulse 0V to 3V; tR = tF = 2.5 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.4V for High and 0.8V for Low.

Note 2: Input pulse UV to 3V; H = tF = 2.5 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.4V for High and 0.8V for Low Note 3: AC Production testing is done at 50 pF.

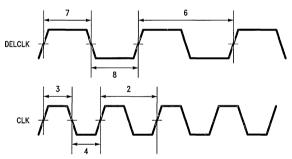


FIGURE 36. Clock, DELCLK Timing

TL/F/8588-E9

13.0 AC Timing Parameters (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$, 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $\begin{array}{l} C_L \ = \ 50 \ \text{pF} \ \text{loads on all outputs except} \\ C_L \ = \ 150 \ \text{pF} \ \text{loads on Q0-8, 9, 10 and } \overline{\text{WE}} ; \ \text{or} \end{array}$

 $C_H=50$ pF loads on all outputs except $C_H=125$ pF loads on $\overline{RAS0-3}$ and $\overline{CAS0-3}$ and $C_H=380$ pF loads on Q0-8, 9, 10 and $\overline{WE}.$

			8	420A/21	A/22A-	20	8	420A/21	A/22A-	25
Number	Symbol	Common Parameter Description		CL	c	н	(CL	c	н
		Description	Min	Max	Min	Max	Min	Max	Min	Max
1	fCLK	CLK Frequency	0	20	0	20	0	25	0	25
2	tCLKP	CLK Period	50		50		40		40	
3, 4	tCLKPW	CLK Pulse Width	15		15		12		12	
5	fDCLK	DELCLK Frequency	5	20	5	20	5	20	5	20
6	tDCLKP	DELCLK Period	50	200	50	200	50	200	50	200
7, 8	tDCLKPW	DELCLK Pulse Width	15		15		12		12	
9a	tPRASCAS0	\overrightarrow{RAS} Asserted to \overrightarrow{CAS} Asserted (tRAH = 15 ns, tASC = 0 ns)	30		30		30		30	
9b	tPRASCAS1	SCAS1 RAS Asserted to CAS Asserted (tRAH = 15 ns, tASC = 10 ns) 40 40		40		40				
9c	tPRASCAS2	CAS2 (RAS Asserted to CAS Asserted (tRAH = 25 ns, tASC = 0 ns) 40 40		40		40				
9d	tPRASCAS3	($\overline{\text{RAS}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 25 ns, tASC = 10 ns)	50		50		50		50	
10a	tRAH	Row Address Hold Time (tRAH = 15)	15		15		15		15	
10b	tRAH	Row Address Hold Time (tRAH = 25)	25		25		25		25	
11a	tASC	Column Address Setup Time (tASC = 0)	0		0		0		0	
11b	tASC	Column Address Setup Time (tASC = 10)	10		10		10		10	
12	tPCKRAS	CLK High to RAS Asserted following Precharge		27		32		22		26
13	tPARQRAS	AREQ Negated to RAS Negated		38		43		31		35
14	tPENCL	ECAS0-3 Asserted to CAS Asserted		23		31		20		27
15	tPENCH	ECAS0-3 Negated to CAS Negated		25		33		20		27
16	tPARQCAS	AREQ Negated to CAS Negated		60		68		47		54
17	tPCLKWH	CLK to WAIT Negated		39		39		31		31
18	tPCLKDL0	CLK to $\overline{\text{DTACK}}$ Asserted (Programmed as $\overline{\text{DTACK}}$ of 1/2, 1, 1½ or if $\overline{\text{WAITIN}}$ is Asserted)	Programmed as DTACK of 1/2, 1, 1½ 33 33			28		28		
19	tPEWL	ECAS Negated to WAIT Asserted during a Burst Access		44		44		36		36
20	tSECK	ECAS Asserted Setup to CLK High to Recognize the Rising Edge of CLK during a Burst Access			24		19		19	

13.0 AC Timing Parameters (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$, 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$ loads on all outputs except $C_L = 150 \text{ pF}$ loads on Q0-8, 9, 10 and $\overline{\text{WE}}$; or

 $C_{H}=50$ pF loads on all outputs except $C_{H}=125$ pF loads on RAS0–3 and CAS0–3 and $C_{H}=380$ pF loads on Q0–8, 9, 10 and WE.

			8	420A/21	A/22A-	20	8420A/21A/22A-25			
Number	Symbol	Common Parameter Description		CL	C	Я		CL	C	н
		Description	Min	Max	Min	Max	Min	Max	Min	Max
21	tPEDL	ECAS Asserted to DTACK Asserted during a Burst Access (Programmed as DTACK0)		48		48		38		38
22	tPEDH	ECAS Negated to DTACK Negated during a Burst Access		49		49		38		38
23	tSWCK	WAITIN Asserted Setup to CLK	5		5		5		5	
24	tPWINWEH	WIN Asserted to WE Asserted		34		44		27		37
25	tPWINWEL	WIN Negated to WE Negated		34		44		27		37
26	tPAQ	Row, Column Address Valid to Q0–8, 9, 10 Valid		29		38		26		35
27	tPCINCQ	COLINC Asserted to Q0-8, 9, 10 Incremented		34		43		30		39
28	tSCINEN	COLINC Asserted Setup to $\overline{\text{ECAS}}$ Asserted to Ensure tASC = 0 ns	18		19		17		19	
29a	tSARQCK1	AREQ, AREQB Negated Setup to CLK High with 1 Period of Precharge	46		46		37		37	
29b	tSARQCK2	$\overline{\text{AREQ}}$, $\overline{\text{AREQB}}$ Negated Setup to CLK High with > 1 Period of Precharge Programmed	19		19		15		15	
30	tPAREQDH	AREQ Negated to DTACK Negated		34		34		27		27
31	tPCKCAS	CLK High to CAS Asserted when Delayed by WIN		31		39		25		32
32	tSCADEN	Column Address Setup to $\overline{\text{ECAS}}$ Asserted to Guarantee tASC = 0	14		15	-	14		16	
33	tWCINC	COLINC Pulse Width	20		20		20		20	_
34a	tPCKCL0	CLK High to \overline{CAS} Asserted following Precharge (tRAH = 15 ns, tASC = 0 ns)		81		89		72		79
34b	tPCKCL1	CLK High to \overline{CAS} Asserted following Precharge (tRAH = 15 ns, tASC = 10 ns)		91		99		82		89
34c	tPCKCL2	CLK High to \overline{CAS} Asserted following Precharge (tRAH = 25 ns, tASC = 0 ns)		91		99		82		89
34d	tPCKCL3	CLK High to \overline{CAS} Asserted following Precharge (tRAH = 25 ns, tASC = 10 ns)		101		109		92		99
35	tCAH	Column Address Hold Time (Interleave Mode Only)	32		32		32		32	
36	tPCQR	CAS Asserted to Row Address Valid (Interleave Mode Only)		90		90		90		90

13.0 AC Timing Parameters (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$, 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$ loads on all outputs except $C_L = 150 \text{ pF}$ loads on Q0-8, 9, 10 and $\overline{\text{WE}}$; or

 $C_H=50$ pF loads on all outputs except $C_H=125$ pF loads on RAS0–3 and CAS0–3 and $C_H=380$ pF loads on Q0–8, 9, 10 and WE.

			ε	420A/21	A/22A-	20	8	420A/21	A/22A-2	25
Number	Symbol	Difference Parameter Description		CL	C	йн		CL	c	йн
	1		Min	Max	Min	Max	Min	Max	Min	Max
50	tD1	(AREQ or AREQB Negated to RAS Negated) Minus (CLK High to RAS Asserted)		16		16		14		14
51	tD2	(CLK High to Refresh RAS Negated) Minus (CLK High to RAS Asserted)		13		13		11		11
52	tD3a	(ADS Asserted to RAS Asserted (Mode 1)) Minus (AREQ Negated to RAS Negated)		4		4		4		4
53	tD3b	(CLK High to RAS Asserted (Mode 0)) Minus (AREQ Negated to RAS Negated)		4		4		4		4
54	tD4	(ECAS Asserted to CAS Asserted) Minus (ECAS Negated to CAS Negated)	-7	7	-7	7	-7	7	-7	7
55	tD5	(CLK to Refresh RAS Asserted) Minus (CLK to Refresh RAS Negated)		6		6		6		6
56	tD6	(AREQ Negated to RAS Negated) Minus (ADS Asserted to RAS Asserted (Mode 1))		12		12		10		10

DP8420A/DP8421A/DP8422A

13.0 AC Timing Parameters (Continued)

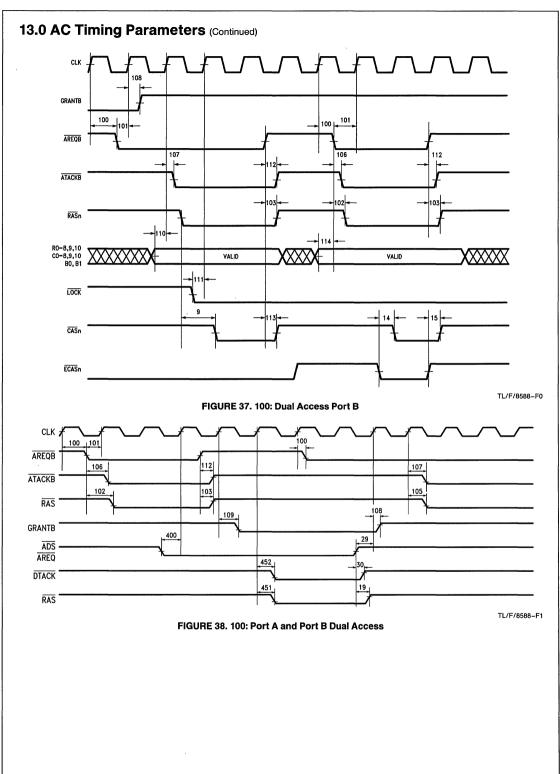
Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$, 0°C < T_A < 70°C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$ loads on all outputs except $C_L = 150 \text{ pF}$ loads on Q0-8, 9, 10 and $\overline{\text{WE}}$; or Т

- $C_H=50$ pF loads on all outputs except $C_H=125$ pF loads on $\overline{RAS0-3}$ and $\overline{CAS0-3}$ and $C_H=380$ pF loads on Q0-8, 9, 10 and $\overline{WE}.$

		Den Britheren	8	420A/21	A/22A-	20	8	420A/21	A/22A-	25
Number	Symbol	Common Dual Access Parameter Description		CL	C	й		CL	C	н
		·	Min	Max	Min	Max	Min	Max	Min	Max
100	tHCKARQB	AREQB Negated Held from CLK High	3		3		3		3	
101	tSARQBCK	AREQB Asserted Setup to CLK High	8		8		7		7	
102	tPAQBRASL	AREQB Asserted to RAS Asserted		43		48		37		41
103	tPAQBRASH	AREQB Negated to RAS Negated		41		46		32		36
105	tPCKRASG	CLK High to RAS Asserted for Pending Port B Access		55		60		44		48
106	tPAQBATKBL	AREQB Asserted to ATACKB Asserted		57		57		45		45
107	tPCKATKB	CLK High to ATACKB Asserted for Pending Access		67		67		51		51
108	tPCKGH	CLK High to GRANTB Asserted		40		40		32		32
109	tPCKGL	CLK High to GRANTB Negated		35		35		29		29
110	tSADDCKG	Row Address Setup to CLK High That Asserts RAS following a GRANTB Change to Ensure tASR = 0 ns for Port B	11		15		11		16	
111	tSLOCKCK	LOCK Asserted Setup to CLK Low to Lock Current Port	5		5		5		5	
112	tPAQATKBH	AREQ Negated to ATACKB Negated		26		26		21		21
113	tPAQBCASH	AREQB Negated to CAS Negated		59		67		47		54
114	tSADAQB	Address Valid Setup to AREQB Asserted	7		11		7		12	
116	tHCKARQG	AREQ Negated Held from CLK High	5		5		5		5	
117	tWAQB	$\overline{\text{AREQB}}$ High Pulse Width to Guarantee tASR = 0 ns	31		35		26		31	
118a	tPAQBCAS0	$\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 15 ns, tASC = 0 ns)		103		111		87		94
118b	tPAQBCAS1	$\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 15 ns, tASC = 10 ns)		113		121		97		104
118c	tPAQBCAS2	$\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 25 ns, tASC = 0 ns)		113		121		97		104
118d	tPAQBCAS3	$\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 25 ns, tASC = 10 ns)		123		131		107		114
120a	tPCKCASG0	CLK High to \overrightarrow{CAS} Asserted for Pending Port B Access (tRAH = 15 ns, tASC = 0 ns)		113		121		96		103
120b	tPCKCASG1	CLK High to \overrightarrow{CAS} Asserted for Pending Port B Access (tRAH = 15 ns, tASC = 10 ns)		123		131		106		113
120c	tPCKCASG2	CLK High to \overline{CAS} Asserted for Pending Port B Access (tRAH = 25 ns, tASC = 0 ns)		123		131		106		113
120d	tPCKCASG3	CLK High to \overline{CAS} Asserted for Pending Port B Access (tRAH = 25 ns, tASC = 10 ns)		133		141		116		123
121	tSBADDCKG	Bank Address Valid Setup to CLK High That Starts RAS for Pending Port B Access	10		10		10		10	

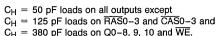


13.0 AC Timing Parameters (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$, 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

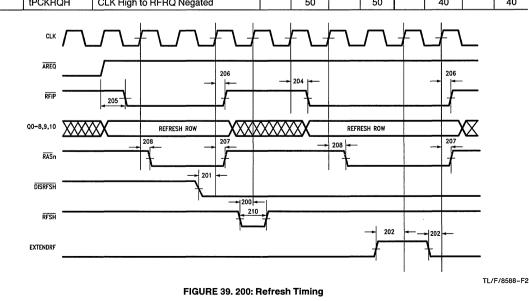
Two different loads are specified:

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 $C_L = 50 \text{ pF}$ loads on all outputs except $C_L = 150 \text{ pF}$ loads on $QO-8, 9, 10 \text{ and } \overline{WF}$ or



$C_L = 1$	50 pF loads on C	20–8, 9, 10 and WE; or	$C_{H} = 380 \text{ pF}$ loads on Q0–8, 9, 10 and WE.							
			8	420A/21	A/22A-	20	8	420A/21	A/22A-	25
Number	Symbol	Refresh Parameter Description		CL	0	н		CL	C	н
		Description	Min	Max	Min	Max	Min	Max	Min	Max
200	tSRFCK	RFSH Asserted Setup to CLK High	27		27		22		22	
201	tSDRFCK	DISRFSH Asserted Setup to CLK High	28		28		22		22	
202	tSXRFCK	EXTENDRF Setup to CLK High	15		15		12		12	
204	tPCKRFL	CLK High to RFIP Asserted		39		39		31		31
205	tPARQRF	AREQ Negated to RFIP Asserted		62		62		50		50
206	tPCKRFH	CLK High to RFIP Negated		65		65		51		51
207	tPCKRFRASH	CLK High to Refresh RAS Negated		35		40		29		33
208	tPCKRFRASL	CLK High to Refresh RAS Asserted		28		33		23		27
209a	tPCKCL0	CLK High to \overline{CAS} Asserted during Error Scrubbing ($t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns}$)		82		90		73		80
209b	tPCKCL1	CLK High to CAS Asserted during Error Scrubbing (t _{RAH} = 15 ns, t _{ASC} = 10 ns)		92		100		83		90
209c	tPCKCL2	CLK High to \overline{CAS} Asserted during Error Scrubbing ($t_{RAH} = 25 \text{ ns}, t_{ASC} = 0 \text{ ns}$)		92		100		83		90
209d	tPCKCL3	CLK High to \overline{CAS} Asserted during Error Scrubbing ($t_{RAH} = 25 \text{ ns}, t_{ASC} = 10 \text{ ns}$)		102		110		93		100
210	tWRFSH	RFSH Pulse Width	15		15		15		15	
211	tPCKRQL	CLK High to RFRQ Asserted		46		46		40		40
212	tPCKRQH	CLK High to RFRQ Negated		50		50		40		40



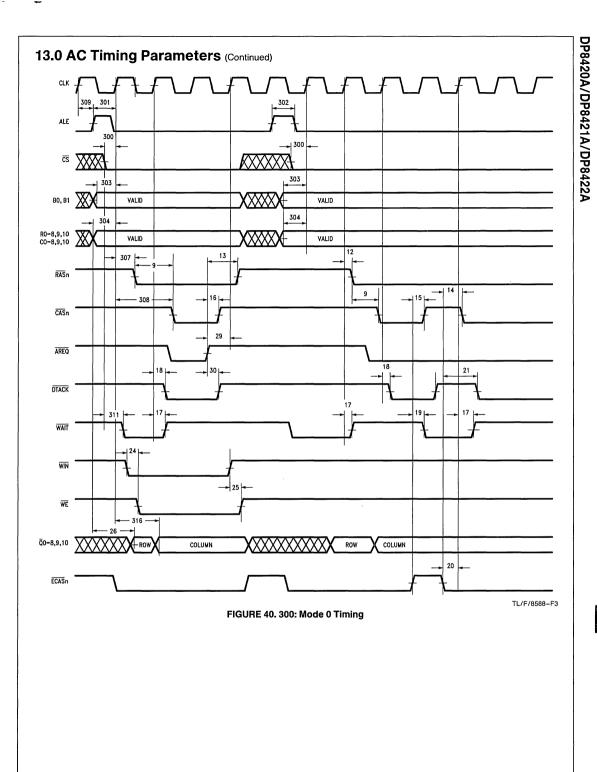
13.0 AC Timing Parameters (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$, 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$ loads on all outputs except $C_L = 150 \text{ pF}$ loads on Q0-8, 9, 10 and $\overline{\text{WE}}$; or

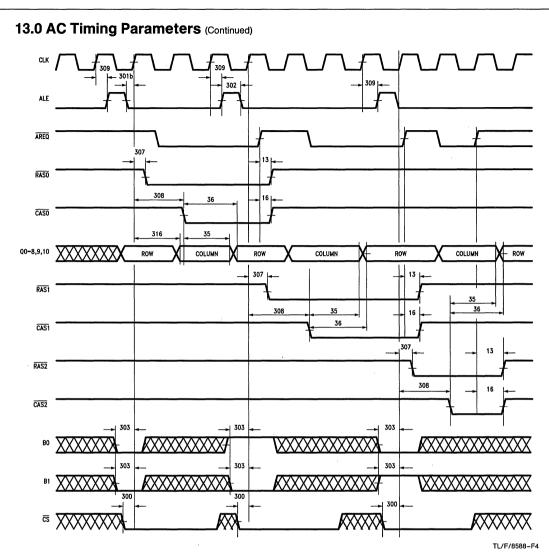
- $C_H=50~\text{pF}$ loads on all outputs except $C_H=125~\text{pF}$ loads on RAS0–3 and CAS0–3 and $C_H=380~\text{pF}$ loads on Q0–8, 9, 10 and WE.

			8	420A/21	A/22A-	20	8	420A/21	A/22A-2	25
Number	Symbol	Mode 0 Access Parameter Description	(CL	C	н	C	Դլ	C	н
		- -	Min	Max	Min	Max	Min	Max	Min	Max
300	tSCSCK	CS Asserted to CLK High	14		14		13		13	
301a	tSALECKNL	ALE Asserted Setup to CLK High Not Using On-Chip Latches or if Using On-Chip Latches and B0, B1, Are Constant, Only 1 Bank	16		16		15		15	
301b	tSALECKL	ALE Asserted Setup to CLK High, if Using On-Chip Latches if B0, B1 Can Change, More Than One Bank	29		29		29		29	
302	tWALE	ALE Pulse Width	18		18		13		13	
303	tSBADDCK	Bank Address Valid Setup to CLK High	20		20		18		18	
304	tSADDCK	Row, Column Valid Setup to CLK High to Guarantee tASR = 0 ns	11		15		11		16	
305	tHASRCB	Row, Column, Bank Address Held from ALE Negated (Using On-Chip Latches)	10		10		8		8	
306	tSRCBAS	Row, Column, Bank Address Setup to ALE Negated (Using On-Chip Latches)	3		3		2		2	
307	tPCKRL	CLK High to RAS Asserted		27		32		22		26
308a	tPCKCL0	CLK High to \overline{CAS} Asserted (t _{RAH} = 15 ns, t _{ASC} = 0 ns)		81		89		72		79
308b	tPCKCL1	CLK High to \overline{CAS} Asserted ($t_{RAH} = 15 \text{ ns}, t_{ASC} = 10 \text{ ns}$)		91		99		82		89
308c	tPCKCL2	CLK High to \overline{CAS} Asserted ($t_{RAH} = 25$ ns, $t_{ASC} = 0$ ns)		91		99		82		89
308d	tPCKCL3	CLK High to \overline{CAS} Asserted ($t_{RAH} = 25$ ns, $t_{ASC} = 10$ ns)		101		109		92		99
309	tHCKALE	ALE Negated Hold from CLK High	0		0		0		0	
310	tSWINCK	$\frac{\text{WIN}}{\text{MIN}} \text{ Asserted Setup to CLK High} \\ \text{to Guarantee } \overline{\text{CAS}} \text{ is Delayed}$	-21		-21		-16		-16	
311	tPCSWL	CS Asserted to WAIT Asserted		26		26		22		22
312	tPCSWH	CS Negated to WAIT Negated		30		30		25		25
313	tPCLKDL1	CLK High to DTACK Asserted (Programmed as DTACK0)		40		40		32		32
314	tPALEWL	ALE Asserted to WAIT Asserted (CS is Already Asserted)		35		35		29		29
315		AREQ Negated to CLK High That Starts Access RAS to Guarantee tASR = 0 ns (Non-Interleaved Mode Only)	41		45		34		39	
316	tPCKCV0	CLK High to Column Address Valid (t _{RAH} = 15 ns, t _{ASC} = 0 ns)		78		87		66		75



1

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(Programmed as C4 = 1, C5 = 1, C6 = 1)



DP8420A/DP8421A/DP8422A

13.0 AC Timing Parameters (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$, 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_{\rm U} = 50$ nE loads on all outputs except

			= 380	pF loa	ds on F ds on C	0-8, 9	, 10 and	WE.		05
		Mode 1 Access			A/22A				A/22A-	
Number	Symbol	Parameter Description)	C		C	-		н
400-			Min	Max	Min	Max	Min	Max	Min	Max
400a	tSADSCK1	ADS Asserted Setup to CLK High	15		15		13		13	
400b	tSADSCKW	ADS Asserted Setup to CLK (to Guarantee Correct WAIT or DTACK Output; Doesn't Apply for DTACK0)	31		31		25		25	
401	tSCSADS	CS Setup to ADS Asserted	6		6		5		5	
402	tPADSRL	ADS Asserted to RAS Asserted		30		35		25		29
403a	tPADSCL0	$\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 15 ns, tASC = 0 ns)		86		94		75		82
403b	tPADSCL1	$\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 15 ns, tASC = 10 ns)		96		104		85		92
403c	tPADSCL2	$\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 25 ns, tASC = 0 ns)		96		104		85		92
403d	tPADSCL3	$\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted (tRAH = 25 ns, tASC = 10 ns)		106		114		95		102
404	tSADDADS	Row Address Valid Setup to $\overline{\text{ADS}}$ Asserted to Guarantee tASR = 0 ns	9		13		9		14	
405	tHCKADS	ADS Negated Held from CLK High	0		0		0		0	
406	tSWADS	WAITIN Asserted Setup to ADS Asserted to Guarantee DTACK0 Is Delayed	0		0		o		0	
407	tSBADAS	Bank Address Setup to ADS Asserted	11		11		11		11	
408	tHASRCB	Row, Column, Bank Address Held from ADS Asserted (Using On-Chip Latches)	10		10		10		10	,
409	tSRCBAS	Row, Column, Bank Address Setup to ADS Asserted (Using On-Chip Latches)	3		3		2		2	
410	tWADSH	ADS Negated Pulse Width	12		16		12		17	
411	tPADSD	ADS Asserted to DTACK Asserted (Programmed as DTACK0)		43		43		35		35
412	tSWINADS	WIN Asserted Setup to ADS Asserted (to Guarantee CAS Delayed during Writes Accesses)	-10		-10		-10		-10	
413	tPADSWL0	ADS Asserted to WAIT Asserted (Programmed as WAIT0, Delayed Access)		35		35		29		29
414	tPADSWL1	ADS Asserted to WAIT Asserted (Programmed WAIT 1/2 or 1)		35		35		29		29
415	tPCLKDL1	CLK High to DTACK Asserted (Programmed as DTACK0, Delayed Access)		40		40		32		32
416		$\overline{\text{AREQ}}$ Negated to $\overline{\text{ADS}}$ Asserted to Guarantee tASR = 0 ns (Non Interleaved Mode Only)	38		42		31		36	
417	tPADSCV0	ADS Asserted to Column		00		00		60		70

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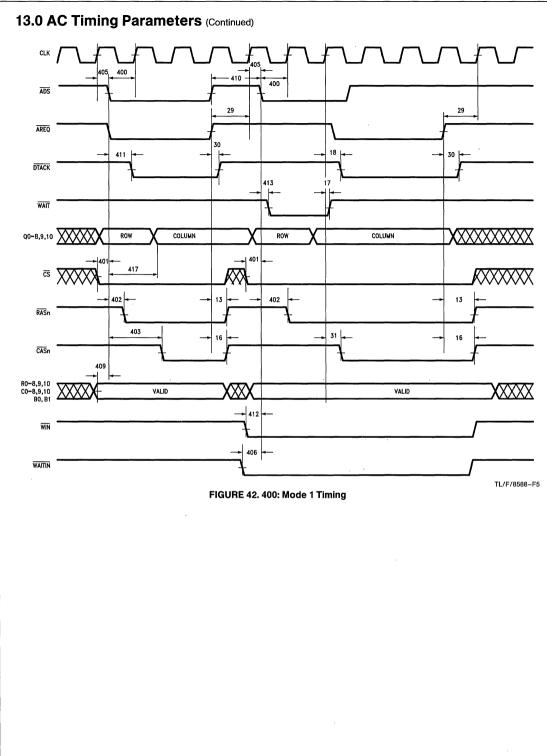
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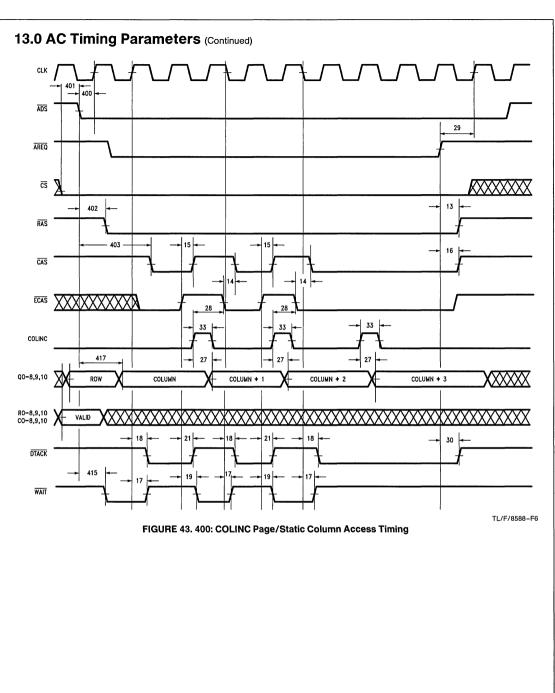
78

Address Valid

 $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns})$



DP8420A/DP8421A/DP8422A



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# 13.0 AC Timing Parameters (Continued)

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C < T<sub>A</sub> < 70°C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

tSADSCK0

ADS Asserted Setup to CLK High

455

 $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0-3 and CAS0-3 and  $C_H=380$  pF loads on Q0-8, 9, 10 and WE.  $C_L = 50 \text{ pF}$  loads on all outputs except  $C_{I} = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or 8420A/21A/22A-20 8420A/21A/22A-25 Mode 1 Dual Access Number Symbol Cı Сн Cı Сн Parameter Description Min Max Min Max Min Max Min Max 450 **tSADDCKG** Row Address Setup to CLK High That Asserts RAS following a GRANTB 11 15 11 16 Port Change to Ensure tASR = 0 ns 451 **tPCKRASG** CLK High to RAS Asserted 48 53 38 42 for Pending Access 452 tPCLKDL2 CLK to DTACK Asserted for Delayed 53 53 43 43 Accesses (Programmed as DTACK0) 453a CLK High to CAS Asserted tPCKCASG0 for Pending Access 101 109 86 93  $(t_{BAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns})$ 453b tPCKCASG1 CLK High to CAS Asserted for Pending Access 111 119 96 103  $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 10 \text{ ns})$ 453c tPCKCASG2 CLK High to CAS Asserted for Pending Access 111 119 96 103  $(t_{RAH} = 25 \text{ ns}, t_{ASC} = 0 \text{ ns})$ CLK High to CAS Asserted 453d tPCKCASG3 for Pending Access 121 129 106 113  $(t_{BAH} = 25 \text{ ns}, t_{ASC} = 10 \text{ ns})$ 454 tSBADDCKG Bank Address Valid Setup to CLK High 5 5 4 4 that Asserts RAS for Pending Access

12

12

11

11

**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

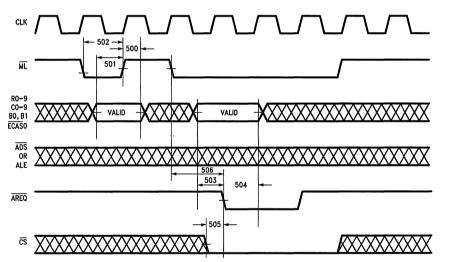
Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or

- $C_H=50~pF$  loads on all outputs except  $C_H=125~pF$  loads on  $\overline{HAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380~pF$  loads on Q0–8, 9, 10 and  $\overline{WE}.$

|        |          |                                       | 84  | 120A/21 | A/22A-         | 20  | 84  | 20A/21 | A/22A- | 25  |
|--------|----------|---------------------------------------|-----|---------|----------------|-----|-----|--------|--------|-----|
| Number | Symbol   | Programming<br>Parameter Description  |     |         | С <sub>Н</sub> |     | CL  |        | С      | ĥ   |
|        |          |                                       | Min | Max     | Min            | Max | Min | Max    | Min    | Max |
| 500    | tHMLADD  | Mode Address Held from ML Negated     | 8   |         | 8              |     | 7   |        | 7      |     |
| 501    | tSADDML  | Mode Address Setup to ML Negated      | 6   |         | 6              |     | 6   |        | 6      |     |
| 502    | tWML     | ML Pulse Width                        | 15  |         | 15             |     | 15  |        | 15     |     |
| 503    | tSADAQML | Mode Address Setup to AREQ Asserted   | 0   |         | 0              |     | 0   |        | 0      |     |
| 504    | tHADAQML | Mode Address Held from AREQ Asserted  | 51  |         | 51             |     | 38  |        | 38     |     |
| 505    | tSCSARQ  | CS Asserted Setup to<br>AREQ Asserted | 6   |         | 6              |     | 6   |        | 6      |     |
| 506    | tSMLARQ  | ML Asserted Setup to AREQ Asserted    | 10  |         | 10             |     | 10  |        | 10     |     |



TL/F/8588-F7

FIGURE 44. 500: Programming

# 14.0 Functional Differences between the DP8420A/21A/22A and the DP8420/21/22

#### 1. Extending the Column Address Strobe (CAS) after AREQ Transitions High

The DP8420A/21A/22A allows  $\overline{CAS}$  to be asserted for an indefinite period of time beyond  $\overline{AREQ}$  (or  $\overline{AREQB}$ , DP8422A only. Scrubbing refreshes are not affected.) being negated by continuing to assert the appropriate  $\overline{ECAS}$ inputs. This feature is allowed as long as the  $\overline{ECAS}$  onput was negated during programming. The DP8420/21/22 does not allow this feature.

#### 2. Dual Accessing

The DP8420A/21A/22A asserts  $\overline{RAS}$  either one or two clock periods after GRANTB has been asserted or negated depending upon how the R0 bit was programmed during the mode load operation. The DP8420/21/22 will always start  $\overline{RAS}$  one clock period after GRANTB is asserted or negated. The above statements assume that  $\overline{RAS}$  precharge has been completed by the time GRANTB is asserted or negated.

#### 3. Refresh Request Output (RFRQ)

The DP8420A/21A/22A allows  $\overline{\text{RFRQ}}$  (refresh request) to be output on the  $\overline{\text{WE}}$  output pin given that  $\overline{\text{ECAS0}}$  was negated during programming or the controller was programmed to function in the address pipelining (memory interleaving) mode. The DP8420/21/22 only allows  $\overline{\text{RFRQ}}$  to be output during the address pipelining mode.

#### 4. Clearing the Refresh Request Clock Counter

The DP8420A/21A/22A allows the internal refresh request clock counter to be cleared by negating DISRFSH and asserting RFSH for at least 500 ns. The DP8420/21/22 clears the internal refresh request clock counter if DISRFSH remains low for at least 500 ns. Once the internal refresh request clock counter is cleared the user is guaranteed that an internally generated RFRQ will not be generated for at least 13  $\mu$ s-15  $\mu$ s (depending upon how programming bits C0, 1, 2, 3 were programmed).

# 15.0 DP8420A/21A/22A User Hints

1. All inputs to the DP8420A/21A/22A should be tied high, low or the output of some other device.

Note: One signal is active high. COLINC (EXTNDRF) should be tied low to disable.

- 2. Each ground on the DP8420A/21A/22A must be decoupled to the closest on-chip supply (V<sub>CC</sub>) with 0.1  $\mu$ F ceramic capacitor. This is necessary because these grounds are kept separate inside the DP8420A/21A/22A. The decoupling capacitors should be placed as close as possible with short leads to the ground and supply pins of the DP8420A/21A/22A.
- 3. The output called "CAP" should have a 0.1  $\mu\text{F}$  capacitor to ground.
- 4. The DP8420A/21A/22A has  $20\Omega$  series damping resistors built into the output drivers of RAS, CAS, address and WE/RFRQ. Space should be provided for external damping resistors on the printed circuit board (or wire-

wrap board) because they may be needed. The value of these damping resistors (if needed) will vary depending upon the output, the capacitance of the load, and the characteristics of the trace as well as the routing of the trace. The value of the damping resistor also may vary between the wire-wrap board and the printed circuit board. To determine the value of the series damping resistor it is recommended to use an oscilloscope and look at the furthest DRAM from the DP8420A/21A/22A. The undershoot of RAS, CAS, WE and the addresses should be kept to less than 0.5V below ground by varying the value of the damping resistors should be placed as close as possible with short leads to the driver outputs of the DP8420A/21A/22A.

- 5. The circuit board must have a good V<sub>CC</sub> and ground plane connection. If the board is wire-wrapped, the V<sub>CC</sub> and ground pins of the DP8420A/21A/22A, the DRAM associated logic and buffer circuitry must be soldered to the V<sub>CC</sub> and ground planes.
- 6. The traces from the DP8420A/21A/22A to the DRAM should be as short as possible.
- ECAS0 should be held low during programming if the user wishes that the DP8420A/21A/22A be compatible with a DP8420/21/22 design.
- 8. Parameter Changes due to Loading

All A.C. parameters are specified with the equivalent load capacitances, including traces, of 64 DRAMs organized as 4 banks of 18 DRAMs each. Maximums are based on worst-case conditions. If an output load changes then the A.C. timing parameters associated with that particular output must be changed. For example, if we changed our output load to

C= 250 pF loads on  $\overline{RAS}0\text{--}3$  and  $\overline{CAS}0\text{--}3$ 

C = 760 pF loads on Q0-9 and  $\overline{WE}$ 

we would have to modify some parameters (not all calculated here)

\$308a clock to CAS asserted

 $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns})$ 

A ratio can be used to figure out the timing change per change in capacitance for a particular parameter by using the specifications and capacitances from heavy and light load timing.

 $Ratio = \frac{\$308a \text{ w/Heavy Load} - \$308a \text{ w/Light Load}}{C_{H}(\overline{CAS}) - C_{L}(\overline{CAS})}$ 

$$= \frac{79 \text{ ns} - 72 \text{ ns}}{125 \text{ pF} - 50 \text{ pF}} = \frac{7 \text{ ns}}{75 \text{ pF}}$$

\$308a (actual) = (capacitance difference × ratio) + \$308a (specified)

= 
$$(250 \text{ pF} - 125 \text{ pF}) \frac{7 \text{ ns}}{75 \text{ pF}} + 79 \text{ ns}$$
  
= 11.7 ns + 79 ns

9. It is required that the user perform a hardware reset of the DP8420A/21A/22A before programming and using the chip. A hardware reset consists of asserting both ML and DISRFSH for a minimum of 16 positive edges of CLK, see Section 3.1.



# PRELIMINARY

# DP8420V/21V/22V-33, DP84T22-25 microCMOS Programmable 256k/1M/4M Dynamic RAM Controller/Drivers

# **General Description**

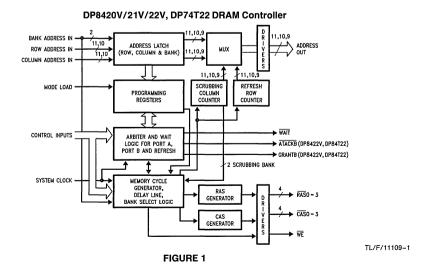
The DP8420V/21V/22V-33. DP84T22-25 dynamic RAM controllers provide a low cost, single chip interface between dynamic RAM and all 8-, 16- and 32-bit systems. The DP8420V/21V/22V-33, DP84T22-25 generate all the required access control signal timing for DRAMs. An on-chip refresh request clock is used to automatically refresh the DRAM array. Refreshes and accesses are arbitrated on chip. If necessary, a WAIT or DTACK output inserts wait states into system access cycles, including burst mode accesses, RAS low time during refreshes and RAS precharge time after refreshes and back to back accesses are guaranteed through the insertion of wait states. Separate on-chip precharge counters for each RAS output can be used for memory interleaving to avoid delayed back to back accesses because of precharge. An additional feature of the DP8422V, DP84T22 is two access ports to simplify dual accessing. Arbitration among these ports and refresh is done on chip. To make board level circuit testing easier the DP84T22 incorporates TRI-STATE® output buffers.

## Features

- On chip high precision delay line to guarantee critical DRAM access timing parameters
- microCMOS process for low power
- High capacitance drivers for RAS, CAS, WE and DRAM address on chip
- On chip support for nibble, page and static column DRAMs
- TRI-STATE outputs (DP84T22 only)
- Byte enable signals on chip allow byte writing in a word size up to 32 bits with no external logic
- Selection of controller speeds: 25 MHz and 33 MHz
- On board Port A/Port B (DP8422V, DP84T22 only)/refresh arbitration logic
- Direct interface to all major microprocessors (application notes available)
- 4 RAS and 4 CAS drivers (the RAS and CAS configuration is programmable)

| Control | # of Pins<br>(PLCC) | # of Address<br>Outputs | Largest<br>DRAM<br>Possible | Direct Drive<br>Memory<br>Capacity | Access<br>Ports<br>Available |
|---------|---------------------|-------------------------|-----------------------------|------------------------------------|------------------------------|
| DP8420V | 68                  | 9                       | 256 kbit                    | 4 Mbytes                           | Single Access Port           |
| DP8421V | 68                  | 10                      | 1 Mbit                      | 16 Mbytes                          | Single Access Port           |
| DP8422V | 84                  | 11                      | 4 Mbit                      | 64 Mbytes                          | Dual Access Ports (A and B)  |
| DP84T22 | 84                  | 11                      | 4 Mbit                      | 64 Mbytes                          | Dual Access and TRI-STATE    |

# **Block Diagram**



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# 1.0 Introduction

The DP8420V/21V/22V, DP84T22 are CMOS Dynamic RAM controllers that incorporate many advanced features which include address latches, refresh counter, refresh clock, row, column and refresh address multiplexer, delay line, refresh/access arbitration logic and high capacitive drivers. The programmable system interface allows any manufacturer's microprocessor or bus to directly interface via the DP8420V/21V/22V, DP84T22 to DRAM arrays up to 64 Mbytes in size.

After power up, the user must first reset and program the DP8420V/21V/22V, DP84T22 before accessing the DRAM. The chip is programmed through the address bus.

#### Reset:

Due to the differences in power supplies, an External (hardware) Reset must be performed before programming the chip.

#### Programming:

After resetting the chip, the user can program the controller by either one of two methods: Mode Load Only Programming or Chip Select Access Programming.

#### Initialization Period:

Once the DP8420V/21V/22V, DP84T22 has been programmed for the first time, a 60 ms initialization period is entered. During this time the DRC performs refreshes to the DRAM array so further warm up cycles are unnecessary. The initialization period is entered only after the first programming after a reset.

#### Accessing Modes:

After resetting and programming the chip, the DP8420V/21V/22V, DP84T22 is ready to access the DRAM. There are two modes of accessing with these controllers. Mode 0, which indicates  $\overline{\text{RAS}}$  synchronously and Mode 1, which indicates  $\overline{\text{RAS}}$  asynchronously.

#### **Refresh Modes:**

The DP8420V/21V/22V, DP84T22 have expanded refresh capabilities compared to previous DRAM controllers. There are three modes of refreshing available: Internal Automatic Refreshing, Externally Controlled/Burst Refreshing and Refresh Request/Acknowledge Refreshing. Any of these modes can be used together or separately to achieve the desired results.

#### **Refresh Types:**

These controllers have three types of refreshing available: Conventional, Staggered and Error Scrubbing. Any refresh control mode can be used with any type of refresh.

#### Wait Support:

The DP8420V/21V/22V, DP84T22 have wait support available as DTACK or WAIT. Both are programmable. DTACK, Data Transfer ACKnowledge, is useful for processors whose wait signal is active high. WAIT is useful for those processors whose wait signal is active low. The user can choose either at programming. These signals are used by the on chip arbiter to insert wait states to guarantee the arbitration between accesses, refreshes and precharge. Both signals are independent of the access mode chosen and both signals can be dynamically delayed further through the WAITIN signal to the DP8420V/21V/22V, DP84T22.

#### Sequential Accesses (Static Column/Page Mode):

The DP8420V/21V/22V, DP84T22 have address latches, used to latch the bank, row and column address inputs.

Once the address is latched, a COLumn INCrement (COL-INC) feature can be used to increment the column address. The address latches can also be programmed to be fall through. COLINC can be used for Sequential Accesses of Static Column DRAMs. Also, COLINC in conjunction with  $\overline{\text{ECAS}}$  inputs can be used for Sequential Accesses to Page Mode DRAMs.

#### RAS and CAS Configuration (Byte Writing):

The  $\overrightarrow{RAS}$  and  $\overrightarrow{CAS}$  drivers can be configured to drive a one, two or four bank memory array up to 32 bits in width. The  $\overrightarrow{ECAS}$  signals can then be used to select one of four  $\overrightarrow{CAS}$ drivers for Byte Writing with no extra logic.

#### Memory Interleaving:

When configuring the DP8420V/21V/22V, DP84T22 for more than one bank, Memory Interleaving can be used. By tying the low order address bits to the bank select lines B0 and B1, sequential back to back accesses will not be delayed since these controllers have separate precharge counters per bank.

#### Address Pipelining:

The DP8420V/21V/22V, DP84T22 are capable of performing Address Pipelining. In address pipelining, the DRC will guarantee the column address hold time and switch the internal multiplexor to place the row address on the address bus. At this time, another memory access to another bank can be initiated.

#### **Dual Accessing:**

The DP8422V, DP84T22 have all the features previously mentioned and unlike the DP8420V/21V, the DP8422V, DP84T22 have a second port to allow a second CPU to access the same memory array. The DP8422V, DP84T22 have four signals to support Dual Accessing, these signals are AREQB, ATACKB, LOCK and GRANTB. All arbitration for the two ports and refresh is done on chip by the controller through the insertion of wait states. Since the DP8422V, DP84T22 have only one input address bus, the address lines must be multiplexed externally. The signal GRANTB can be used for this purpose.

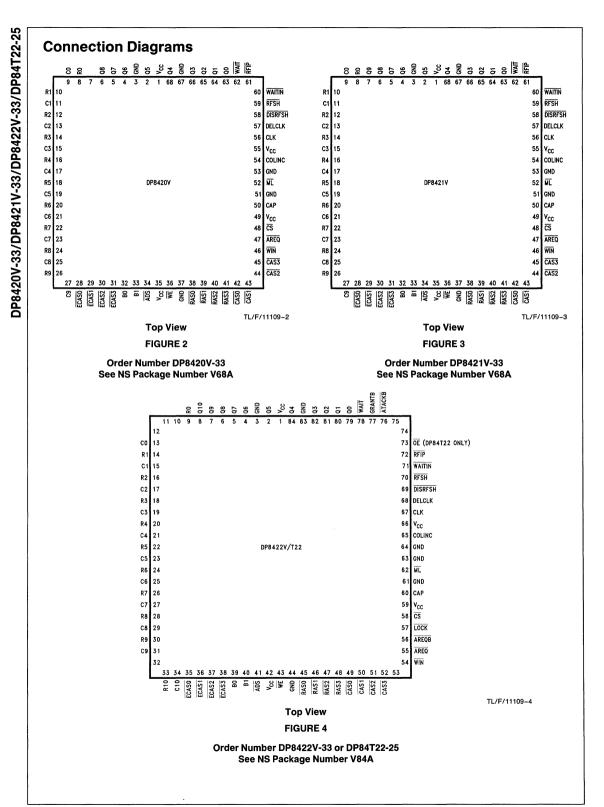
#### **TRI-STATE Outputs:**

The DP84T22 implements TRI-STATE outputs. When the input  $\overline{OE}$  is asserted the output buffers are enabled, when  $\overline{OE}$  is negated, logic 1, the output buffers at TRI-STATE (high Z).

#### Terminology:

The following explains the terminology used in this data sheet. The terms negated and asserted are used. Asserted refers to a "true" signal. Thus, "ECAS0 asserted" means the ECAS0 input is at a logic 0. The term "COLINC asserted" means the COLINC input is at a logic 1. The term negated refers to a "false" signal. Thus, "ECAS0 negated" means the ECAS0 input is at a logic 1. The term "COLINC negated" means the ECAS0 input is at a logic 1. The term "COLINC negated" means the input COLINC is at a logic 0. The term "COLINC negated" means the input COLINC is at a logic 0. The table shown below clarifies this terminology.

| Signal      | Action   | Logic Level |
|-------------|----------|-------------|
| Active High | Asserted | High        |
| Active High | Negated  | Low         |
| Active Low  | Asserted | Low         |
| Active Low  | Negated  | High        |



| Pin<br>Name           | Device (If Not<br>Applicable to All) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|-----------------------|--------------------------------------|------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.1 ADDRESS           | , R/W AND PROGRA                     | AMMING S         | IGNALS                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| R0–10<br>R0–9         | DP8422V/T22<br>DP8420V/21V           |                  | <b>ROW ADDRESS:</b> These inputs are used to specify the row address during an access to the DRAM. They are also used to program the chip when ML is asserted (except R10).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| C0-10<br>C0-9         | DP8422V/T22<br>DP8420V/21V           |                  | <b>COLUMN ADDRESS:</b> These inputs are used to specify the column address during an access to the DRAM. They are also used to program the chip when $\overline{ML}$ is asserted (except C10).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| B0, B1                |                                      | I                | BANK SELECT: Depending on programming, these inputs are used to select a group of $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ outputs to assert during an access. They are also used to program the chip when $\overline{\text{ML}}$ is asserted.                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| ECAS0-3               |                                      | I                | <b>ENABLE CAS:</b> These inputs are used to enable a single or group of CAS outputs when asserted. In combination with the B0, B1 and the programming bits, these inputs select which CAS output or CAS outputs will assert during an access. The ECAS signals can also be used to toggle a group of CAS outputs for page/nibble mode accesses. They also can be used for byte write operations. If ECAS0 is negated during programming, continuing to assert the ECAS0 while negating AREQ or AREQB during an access, will cause the CAS0 outputs to be extended while the RAS outputs are negated (the ECASn inputs have no effect during scrubbing refreshes).                          |
| WIN                   |                                      | I                | <b>WRITE ENABLE IN:</b> This input is used to signify a write operation to the DRAM. If ECAS0 is asserted during programming, the $\overline{WE}$ output will follow this input. This input asserted will also cause $\overline{CAS}$ to delay to the next positive clock edge if address bit C9 is asserted during programming.                                                                                                                                                                                                                                                                                                                                                           |
| COLINC<br>(EXTNDRF)   |                                      | l                | <b>COLUMN INCREMENT:</b> When the address latches are used, and $\overrightarrow{RFIP}$ is negated, this input functions as COLINC. Asserting this signal causes the column address to be incremented by one. When $\overrightarrow{RFIP}$ is asserted, this signal is used to extend the refresh cycle by any number of periods of CLK until it is negated.                                                                                                                                                                                                                                                                                                                               |
| ML                    |                                      | I                | <b>MODE LOAD:</b> This input signal, when low, enables the internal programming register that stores the programming information.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 2.2 DRAM CO           | NTROL SIGNALS                        |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| Q0-10<br>Q0-9<br>Q0-8 | DP8422V/T22<br>DP8421V<br>DP8421V    | 0<br>0<br>0      | <b>DRAM ADDRESS:</b> These outputs are the multiplexed output of the R0–9, 10 and C0–9, 10 and form the DRAM address bus. These outputs contain the refresh address whenever RFIP is asserted. They contain high capacitive drivers with $20\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                                                                                                              |
| RAS0-3                |                                      | 0                | <b>ROW ADDRESS STROBES:</b> These outputs are asserted to latch the row address contained on the outputs $Q0-8$ , 9, 10 into the DRAM. When $\overrightarrow{RFIP}$ is asserted, the $\overrightarrow{RAS}$ outputs are used to latch the refresh row address contained on the $Q0-8$ , 9, 10 outputs in the DRAM. These outputs contain high capacitive drivers with $20\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                 |
| CAS0-3                |                                      | 0                | COLUMN ADDRESS STROBES: These outputs are asserted to latch the column address contained on the outputs $QO-8$ , 9, 10 into the DRAM. These outputs have high capacitive drivers with $20\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| WE<br>(RFRQ)          |                                      | 0                | WRITE ENABLE or REFRESH REQUEST: This output asserted specifies a write operation to the DRAM. When negated, this output specifies a read operation to the DRAM. When the controller is programmed in address pipelining mode or when ECAS0 is negated during programming, this output will function as RFRQ. When asserted, this pin specifies that 13 $\mu$ s or 15 $\mu$ s have passed. If DISRFSH is negated, the DP8420V/21V/22V, DP84T22 will perform an internal refresh as soon as possible. If DISRFRSH is asserted, RFRQ can be used to externally request a refresh through the input RFSH. This output has a high capacitive driver and a 20 $\Omega$ series damping resistor. |
| ŌĒ                    | DP84T22<br>(Only)                    | I                | OUTPUT ENABLE: This input asserted, enables the output buffers for the row, column RASs, CASs and WE. If this input is disabled, logic 1, the output buffers are at TRI-STATE facilitating the board level circuit testing.                                                                                                                                                                                                                                                                                                                                                                                                                                                                |

\_\_\_\_\_

\*\*\*

| Pin<br>Name<br>2.3 REFRES | Device (If Not<br>Applicable to All)<br>H SIGNALS | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|---------------------------|---------------------------------------------------|------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RFIP                      |                                                   | 0                | <b>REFRESH IN PROGRESS:</b> This output is asserted prior to a refresh cycle and is negated when all the RAS outputs are negated for that refresh.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| RFSH                      |                                                   | I                | <b>REFRESH:</b> This input asserted with DISRFRSH already asserted will request a refresh. If this input is continually asserted, the DP8420V/21V/22V, DP84T22 will perform refresh cycles in a burst refresh fashion until the input is negated. If RFSH is asserted with DISRFSH negated, the internal refresh address counter is cleared (useful for burst refreshes).                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| DISRFSH                   |                                                   | t                | <b>DISABLE REFRESH:</b> This input is used to disable internal refreshes and must be asserted when using RFSH for externally requested refreshes.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 2.4 PORT A                | ACCESS SIGNALS                                    |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| ADS<br>(ALE)              |                                                   | I                | ADDRESS STROBE or ADDRESS LATCH ENABLE: Depending on programming, this input can function as $\overline{\text{ADS}}$ or ALE. In mode 0, the input functions as ALE and when asserted along with $\overline{\text{CS}}$ causes an internal latch to be set. Once this latch is set an access will start from the positive clock edge of CLK as soon as possible. In Mode 1, the input functions as $\overline{\text{ADS}}$ and when asserted along with $\overline{\text{CS}}$ causes the access $\overline{\text{RAS}}$ to assert if no other event is taking place. If an event is taking place, $\overline{\text{RAS}}$ will be asserted from the positive edge of CLK as soon as possible. In both cases, the low going edge of this signal latches the bank, row and column address if programmed to do so. |
| CS                        |                                                   | 1                | CHIP SELECT: This input signal must be asserted to enable a Port A access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| ĀREQ                      |                                                   | I                | ACCESS REQUEST: This input signal in Mode 0 must be asserted some time after<br>the first positive clock edge after ALE has been asserted. When this signal is<br>negated, RAS is negated for the access. In Mode 1, this signal must be asserted<br>before ADS can be negated. When this signal is negated, RAS is negated for the<br>access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| WAIT<br>(DTACK)           |                                                   | 0<br>0           | WAIT or DTACK: This output can be programmed to insert wait states into a CPU access cycle. With R7 negated during programming, the output will function as a WAIT type output. In this case, the output will be active low to signal a wait condition. With R7 asserted during programming, the output will function as DTACK. In this case, the output will be negated to signify a wait condition and will be asserted to signify the access has taken place. Each of these signals can be delayed by a number of positive clock edges or negative clock levels of CLK to increase the microprocessor's access cycle through the insertion of wait states.                                                                                                                                                   |
| WAITIN                    |                                                   | Ι                | WAIT INCREASE: This input can be used to dynamically increase the number of positive clock edges of CLK until DTACK will be asserted or WAIT will be negated during a DRAM access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |

| Name            | Device (If Not<br>Applicable to All) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|-----------------|--------------------------------------|------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| .5 PORT B       | ACCESS SIGNALS                       |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| AREQB           | DP8422V/T22<br>only                  | 1                | <b>PORT B ACCESS REQUEST:</b> This input asserted will latch the row, column and bank address if programmed, and requests an access to take place for Port B. If the access can take place, RAS will assert immediately. If the access has to be delayed, RAS will assert as soon as possible from a positive edge of CLK.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| ATACKB          | DP8422V/T22<br>only                  | 0                | ADVANCED TRANSFER ACKNOWLEDGE PORT B: This output is asserted when<br>the access RAS is asserted for a Port B access. This signal can be used to generate<br>the appropriate DTACK or WAIT type signal for Port B's CPU or bus.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 2.6 COMMO       | N DUAL PORT SIGN                     | ALS              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| GRANTB          | DP8422V/T22<br>only                  | 0                | <b>GRANT B:</b> This output indicates which port is currently granted access to the DRAM array. When GRANTB is asserted, Port B has access to the array. When GRANTB is negated, Port A has access to the DRAM array. This signal is used to multiplex the signals $R0-8$ , 9, 10; $C0-8$ , 9, 10; $B0-1$ ; WIN; LOCK and ECAS0-3 to the DP8422V when using dual accessing.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| LOCK            | DP8422V/T22<br>only                  | 1                | LOCK: This input can be used by the currently granted port to "lock out" the other<br>port from the DRAM array by inserting wait states into the locked out port's access<br>cycle until LOCK is negated.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 2.7 POWER       | SIGNALS AND CAP                      | CITOR IN         | PUT                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| V <sub>CC</sub> |                                      | I                | POWER: Supply Voltage.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| GND             |                                      | 1                | GROUND: Supply Voltage Reference.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| CAP             |                                      | I                | <b>CAPACITOR:</b> This input is used by the internal PLL for stabilization. The value of the ceramic capacitor should be 0.1 $\mu$ F and should be connected between this input and ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|                 |                                      |                  | parate clocks, running at different frequencies, asynchronous to each other.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| CLK<br>DELCLK   |                                      | T                | <ul> <li>SYSTEM CLOCK: This input may be in the range of 0 Hz up to 33 MHz (up to 25 MHz in the DP84T22V). This input is generally a constant frequency but it may be controlled externally to change frequencies or perhaps be stopped for some arbitrary period of time.</li> <li>This input provides the clock to the internal state machine that arbitrates between accesses and refreshes. This clock's positive edges and negative levels are used to extend the WAIT (DTACK) signals. This clock is also used as the reference for the RAS precharge time and RAS low time during refresh.</li> <li>All Port A and Port B accesses are assumed to be synchronous to the system clock CLK.</li> <li>DELAY LINE CLOCK: The clock input DELCLK, may be in the range of 6 MHz to 20 MHz and should be a multiple of 2 (i.e., 6, 8, 10, 12, 14, 16, 18, 20 MHz) to have the DP8420V/21V/22V, DP84T22 switching characteristics hold. If DELCLK is not one of the above frequencies the accuracy of the internal delay line will suffer. This is because the phase locked loop that generates the delay line assumes an input clock frequency of a multiple of 2 MHz.</li> <li>For example, if the DELCLK input is at 7 MHz and we choose a divide by 3 (program bits C0–2) this will produce 2.333 MHz which is 16.667% off of 2 MHz. Therefore, the DP8420V/21V/22V, DP84T22 delay line would produce delays that are shorter (faster delays) than intended. If divide by 4 was chosen the delay line would be longer (slower delays) than intended (1.75 MHz instead of 2 MHz). (See Section 9 for more information.)</li> </ul> |

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# 3.0 Programming and Resetting

Due to the variety in power supplies power-up times, an EXTERNAL RESET must be performed before the DRAM controller can be programmed and used.

After going through the reset procedure, the DP8420V/ 21V/22V, DP84T22 can be programmed by either of two methods; Mode Load Only Programming or Chip Select Access Programming. After programming the DRC for the first time after reset, the chip enters a 60 ms initialization period, during this period the controller performs refreshes every 13  $\mu$ s or 15  $\mu$ s, this makes further DRAM warm up cycles unnecessary. After this stage the chip can be reprogrammed as many times as the user wishes and the 60 ms period will not be entered into unless the chip is reset and programmed again.

During the 60 ms initialization period,  $\overrightarrow{\text{RFIP}}$  is asserted low and  $\overrightarrow{\text{RAS}}$  toggles every 13  $\mu$ s or 15  $\mu$ s depending on the programming bit for refresh (C3).  $\overrightarrow{\text{CAS}}$  will be inactive (logic 1) and the "Q" outputs will count from 0 to 2047 refreshing the entire DRAM array. The actual initialization time period is given by the following formula. T = 4096\* (Clock Divisor Select)\* (Refresh Clock Fine Tune)/(DELCLK Frq.)

#### **3.1 EXTERNAL RESET**

At power up, if the internal power up reset worked, all internal latches and flip-flops are cleared and the part is ready to be programmed. The power up state can also be achieved by performing an External Reset, which is required to insure proper operation. External Reset is achieved by asserting ML and DISRFSH for at least 16 positive clock edges. In order to perform simply a Reset, the ML signal must be negated before DISRFSH is negated as shown in *Figure 5a*. This procedure will only reset the controller which now is ready for programming.

While performing an External Reset, if the user negates DISRFSH at least one clock period before negating  $\overline{ML}$ , as shown in *Figure 5b*,  $\overline{ML}$  negated will program the DP8420V/21V/22V, DP84T22 with the values in R0–9, C0–9, B0–1 and ECAS0. The 60 ms initialization period will be entered since it is the first programming after reset. This is a good way of resetting and programming the part at the same time. Make sure the right programming bits are on the address bus before  $\overline{ML}$  is negated.

The DRC may be Reset and programmed any time on the fly, but the user must make sure that No Access or Refresh is in progress.

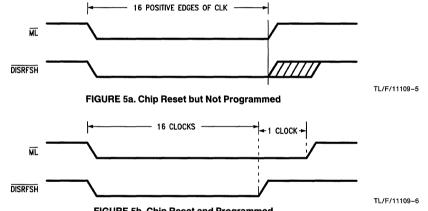


FIGURE 5b. Chip Reset and Programmed

## 3.2 PROGRAMMING METHODS

## 3.2.1 Mode Load Only Programming

To use this method the user asserts  $\overline{\text{ML}}$  enabling the internal programming register. After  $\overline{\text{ML}}$  is asserted, a valid programming selection is placed on the address bus, B0, B1 and ECAS0 inputs, then  $\overline{\text{ML}}$  is negated. When  $\overline{\text{ML}}$  is negated the programming bits are latched into the internal programming register and the DP8420V/21V/22V, DP84T22 is programmed, see *Figure 6*. When programming the chip, the controller must not be refreshing,  $\overline{\text{RFIP}}$  must be high (1) to have a successful programming.

#### 3.2.2 Chip Selected Access Programming

The chip can also be programmed by performing a chip selected access. To program the chip using this method,  $\overline{\text{ML}}$  is asserted, then  $\overline{\text{CS}}$  is asserted and a valid programming selection is placed on the address bus. When  $\overline{\text{AREQ}}$  is asserted, the programming bits affecting the wait logic become effective immediately, then  $\overline{\text{DTACK}}$  is asserted allowing the access to terminate. After the access,  $\overline{\text{ML}}$  is negated and the rest of the programming bits take effect.

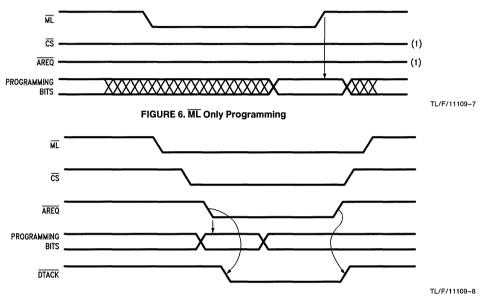


FIGURE 7. CS Access Programming

DP8420V-33/DP8421V-33/DP8422V-33/DP84T22-25

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| Symbol     | nbol Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |  |  |  |  |
|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|
| ECAS0      | Extend CAS/Refresh Request Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |  |  |  |  |
| 0          | The CASn outputs will be negated with the RASn outputs when AREQ (or AREQB, DP8422V, DP84T22 or negated. The WE output pin will function as write enable.                                                                                                                                                                                                                                                                                                                                                      |  |  |  |  |
| 1          | The CASn outputs will be negated, during an acccess (Port A (or Port B, DP8422V, DP84T22 only)) when their corresponding ECASn inputs are negated. This feature allows the CAS outputs to be extended beyond the RAS outputs negating. Scrubbing refreshes are NOT affected. During scrubbing refreshes the CAS outputs will negating with the RAS outputs regardless of the state of the ECAS inputs. The WE output will function as ReFresh ReQuest (RFRQ) when this mode is programmed.                     |  |  |  |  |
| B1         | Access Mode Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |  |  |  |  |
| 0          | ACCESS MODE 0: ALE pulsing high sets an internal latch. On the next positive edge of CLK, the access (RAS) will start. AREQ will terminate the access.                                                                                                                                                                                                                                                                                                                                                         |  |  |  |  |
| 1          | ACCESS MODE 1: ADS asserted starts the access (RAS) immediately. AREQ will terminate the access.                                                                                                                                                                                                                                                                                                                                                                                                               |  |  |  |  |
| B0         | Address Latch Mode                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |  |  |  |  |
| 0          | ADS or ALE asserted for Port A or AREQB asserted for Port B with the appropriate GRANT latch the input row, column and bank address.                                                                                                                                                                                                                                                                                                                                                                           |  |  |  |  |
| 1          | The row, column and bank latches are fall through.                                                                                                                                                                                                                                                                                                                                                                                                                                                             |  |  |  |  |
| C9         | Delay CAS during WRITE Accesses                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |  |  |  |  |
| 0          | CAS is treated the same for both READ and WRITE accesses.                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |  |  |
| 1          | During WRITE accesses, CAS will be asserted by the event that occurs last: CAS asserted by the internal delay line or CAS asserted on the positive edge of CLK after RAS is asserted.                                                                                                                                                                                                                                                                                                                          |  |  |  |  |
| C8         | Row Address Hold Time                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |  |  |  |  |
| 0          | Row Address Hold Time = 25 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |  |  |  |  |
| 1          | Row Address Hold Time = 15 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |  |  |  |  |
| C7         | Column Address Setup Time                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |  |  |
| 0          | Column Address Setup Time = 10 ns miniumum                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |  |  |  |  |
| 1          | Column Address Setup Time = 0 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |  |  |  |  |
| C6, C5, C4 | RAS and CAS Configuration Modes/Error Scrubbing during Refresh                                                                                                                                                                                                                                                                                                                                                                                                                                                 |  |  |  |  |
| 0, 0, 0    | RAS0-3 and CAS0-3 are all selected during an access. ECASn must be asserted for CASn to be asserted.<br>B0 and B1 are not used during an access. Error scrubbing during refresh.                                                                                                                                                                                                                                                                                                                               |  |  |  |  |
| 0, 0, 1    | RAS and CAS pairs are selected during an access by B1. ECASn must be asserted for CASn to be asserted.         B1 = 0 during an access selects RAS0-1 and CAS0-1.         B1 = 1 during an access selects RAS2-3 and CAS2-3.         B0 is not used during an Access.         Error scrubbing during refresh.                                                                                                                                                                                                  |  |  |  |  |
| 0, 1, 0    | RAS and CAS singles are selected during an access by B0-1. ECASn must be asserted for $\overline{CASn}$ to be asserted.<br>B1 = 0, B0 = 0 during an access selects $\overline{RAS0}$ and $\overline{CAS0}$ .<br>B1 = 0, B0 = 1 during an access selects $\overline{RAS1}$ and $\overline{CAS1}$ .<br>B1 = 1, B0 = 0 during an access selects $\overline{RAS2}$ and $\overline{CAS2}$ .<br>B1 = 1, B0 = 1 during an access selects $\overline{RAS3}$ and $\overline{CAS3}$ .<br>Error scrubbing during refresh. |  |  |  |  |
| 0, 1, 1    | RAS0-3 and CAS0-3 are all selected during an access. ECASn must be asserted for CASn to be asserted.<br>B1, B0 are not used during an access.<br>No error scrubbing. (RAS only refreshing)                                                                                                                                                                                                                                                                                                                     |  |  |  |  |
| 1, 0, 0    | RAS pairs are selected by B1. CAS0-3 are all selected. ECASn must be asserted for CASn to be asserted.         B1 = 0 during an access selects RAS0-1 and CAS0-3.         B1 = 1 during an access selects RAS2-3 and CAS0-3.         B0 is not used during an access.         No error scrubbing.                                                                                                                                                                                                              |  |  |  |  |

3.3 PROGRAMMING BIT DEFINITIONS (Continued)

| Symbol     | Description                                                                                                                                                            |  |  |
|------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| C6, C5, C4 | RAS and CAS Configuration Modes (Continued)                                                                                                                            |  |  |
| 1, 0, 1    | RAS and CAS pairs are selected by B1. ECASn must be asserted for CASn to be asserted.                                                                                  |  |  |
|            | B1 = 0 during an access selects $\overline{RAS}0-1$ and $\overline{CAS}0-1$ .                                                                                          |  |  |
|            | B1 = 1 during an access selects $\overline{RAS2}$ -3 and $\overline{CAS2}$ -3.                                                                                         |  |  |
|            | B0 is not used during an access.                                                                                                                                       |  |  |
|            | No error scrubbing.                                                                                                                                                    |  |  |
| 1, 1, 0    | RAS singles are selected by B0-1. CAS0-3 are all selected. ECASn must be asserted for CASn to be<br>asserted.                                                          |  |  |
|            | $B1 = 0, B0 = 0$ during an access selects $\overline{RAS0}$ and $\overline{CAS0}$ – 3.                                                                                 |  |  |
|            | B1 = 0, B0 = 1 during an access selects $\overline{RAS}1$ and $\overline{CAS}0-3$ .                                                                                    |  |  |
|            | B1 = 1, B0 = 0 during an access selects $\overrightarrow{RAS2}$ and $\overrightarrow{CAS0}$ -3.                                                                        |  |  |
|            | B1 = 1, B0 = 1 during an access selects $\overline{RAS3}$ and $\overline{CAS0}$ -3.                                                                                    |  |  |
|            | No error scrubbing.                                                                                                                                                    |  |  |
| 1, 1, 1    | RAS and CAS singles are selected by B0, 1. ECASn must be asserted for CASn to be asserted.                                                                             |  |  |
|            | B1 = 0, B0 = 0 during an access selects $\overline{RAS0}$ and $\overline{CAS0}$ .<br>B1 = 0, B0 = 1 during an access selects $\overline{RAS1}$ and $\overline{CAS1}$ . |  |  |
|            | BT = 0, B0 = 1 during an access selects TAST and CAST.<br>B1 = 1, B0 = 0 during an access selects TAS2 and CAS2.                                                       |  |  |
|            | $B1 = 1, B0 = 1$ during an access selects $\overline{RAS3}$ and $\overline{CAS3}$ .                                                                                    |  |  |
|            | No error scrubbing.                                                                                                                                                    |  |  |
| C3         | Refresh Clock Fine Tune Divisor                                                                                                                                        |  |  |
| 0          | Divide delay line/refresh clock further by 30 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 15 $\mu$ s refresh period).                                             |  |  |
| 1          | Divide delay line/refresh clock further by 26 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 13 $\mu$ s refresh period).                                             |  |  |
| C2, C1, C0 | Delay Line/Refresh Clock Divisor Select                                                                                                                                |  |  |
| 0, 0, 0    | Divide DELCLK by 10 to get as close to 2 MHz as possible.                                                                                                              |  |  |
| 0, 0, 1    | Divide DELCLK by 9 to get as close to 2 MHz as possible.                                                                                                               |  |  |
| 0, 1, 0    | Divide DELCLK by 8 to get as close to 2 MHz as possible.                                                                                                               |  |  |
| 0, 1, 1    | Divide DELCLK by 7 to get as close to 2 MHz as possible.                                                                                                               |  |  |
| 1, 0, 0    | Divide DELCLK by 6 to get as close to 2 MHz as possible.                                                                                                               |  |  |
| 1, 0, 1    | Divide DELCLK by 5 to get as close to 2 MHz as possible.                                                                                                               |  |  |
| 1, 1, 0    | Divide DELCLK by 4 to get as close to 2 MHz as possible.                                                                                                               |  |  |
| 1, 1, 1    | Divide DELCLK by 3 to get as close to 2 MHz as possible.                                                                                                               |  |  |
| R9         | Refresh Mode Select                                                                                                                                                    |  |  |
| 0          | RAS0-3 will all assert and negate at the same time during a refresh.                                                                                                   |  |  |
| 1          | Staggered Refresh. RAS outputs during refresh are separated by one positive clock edge. Depending on the                                                               |  |  |
|            | configuration mode chosen, either one or two RASs will be asserted.                                                                                                    |  |  |
| R8         | Address Pipelining Select                                                                                                                                              |  |  |
| 0          | Address pipelining is selected. The DRAM controller will switch the DRAM column address back to the row                                                                |  |  |
|            | address after guaranteeing the column address hold time.                                                                                                               |  |  |
| 1          | Non-address pipelining is selected. The DRAM controller will hold the column address on the DRAM address<br>bus until the access RASs are negated.                     |  |  |
| R7         | WAIT or DTACK Select                                                                                                                                                   |  |  |
| 0<br>1     | WAIT type output is selected.<br>DTACK (Data Transfer ACKnowledge) type output is selected.                                                                            |  |  |
| R6         | Add Wait States to the Current Access if WAITIN is Low                                                                                                                 |  |  |
| 0          | WAIT or DTACK will be delayed by one additional positive edge of CLK.                                                                                                  |  |  |
| 1          | WAIT or DTACK will be delayed by two additional positive edges of CLK.                                                                                                 |  |  |

3.3 PROGRAMMING BIT DEFINITIONS (Continued)

| Symbol | Description                                                                                                                                                                                                                                                                   |  |  |  |  |
|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|
| R5, R4 | WAIT/DTACK during Burst (See Section 5.1.2 or 5.2.2)                                                                                                                                                                                                                          |  |  |  |  |
| 0, 0   | NO WAIT STATES; If $R7 = 0$ during programming, WAIT will remain negated during burst portion of access.                                                                                                                                                                      |  |  |  |  |
|        | If R7 = 1 programming, DTACK will remain asserted during burst portion of access.                                                                                                                                                                                             |  |  |  |  |
| 0, 1   | 1T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated with AREQ asserted.<br>WAIT will negate from the positive edge of CLK after the ECASs have been asserted.                                                                                 |  |  |  |  |
|        | If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted.<br>DTACK will assert from the positive edge of CLK after the ECASs have been asserted.                                                                                   |  |  |  |  |
| 1,0    | $\frac{1}{2}$ T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated with AREQ asserted.<br>WAIT will negate on the negative level of CLK after the ECASs have been asserted.                                                                     |  |  |  |  |
|        | If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted.<br>DTACK will assert from the negative level of CLK after the ECASs have been asserted.                                                                                  |  |  |  |  |
| 1, 1   | 0T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated. WAIT will negate when the ECAS inputs are asserted.                                                                                                                                      |  |  |  |  |
|        | If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated. DTACK will assert when the ECAS inputs are asserted.                                                                                                                                        |  |  |  |  |
| R3, R2 | WAIT/DTACK Delay Times (See Section 5.1.1 or 5.2.1)                                                                                                                                                                                                                           |  |  |  |  |
| 0, 0   | NO WAIT STATES: If R7 = 0 during programming, WAIT will remain high during non-delayed accesses. WAIT will negate when RAS is negated during delayed accesses.                                                                                                                |  |  |  |  |
|        | NO WAIT STATES; If R7 = 1 during programming, DTACK will be asserted when RAS is asserted.                                                                                                                                                                                    |  |  |  |  |
| 0, 1   | 1/2T; If R7 = 0 during programming, WAIT will negate on the negative level of CLK, after the access RAS.<br>1T; If R7 = 1 during programming, DTACK will be asserted on the positive edge of CLK after the access RAS.                                                        |  |  |  |  |
| 1,0    | NO WAIT STATES, $1/_2$ T; If R7 = 0 during programming, WAIT will remain high during non-delayed accesses.<br>WAIT will negate on the negative level of CLK, after the access RAS, during delayed accesses.                                                                   |  |  |  |  |
|        | $\frac{1}{2}$ T; If R7 = 1 during programming, DTACK will be asserted on the negative level of CLK after the access RAS.                                                                                                                                                      |  |  |  |  |
| 1, 1   | <ul> <li>1T; If R7 = 0 during programming, WAIT will negate on the positive edge of CLK after the access RAS.</li> <li>1½T; If R7 = 1 during programming, DTACK will be asserted on the negative level of CLK after the positive edge of CLK after the access RAS.</li> </ul> |  |  |  |  |
| R1, R0 | RAS Low and RAS Precharge Time                                                                                                                                                                                                                                                |  |  |  |  |
| 0,0    | $\overline{RAS}$ asserted during refresh = 2 positive edges of CLK.                                                                                                                                                                                                           |  |  |  |  |
|        | $\overline{RAS}$ precharge time = 1 positive edge of CLK.                                                                                                                                                                                                                     |  |  |  |  |
|        | RAS will start from the first positive edge of CLK after GRANTB transitions (DP8422V, DP84T22).                                                                                                                                                                               |  |  |  |  |
| 0, 1   | $\overline{RAS}$ asserted during refresh = 3 positive edges of CLK.                                                                                                                                                                                                           |  |  |  |  |
|        | $\overline{RAS}$ precharge time = 2 positive edges of CLK.                                                                                                                                                                                                                    |  |  |  |  |
|        | RAS will start from the second positive edge of CLK after GRANTB transitions (DP8422V, DP84T22).                                                                                                                                                                              |  |  |  |  |
| 1,0    | $\overrightarrow{RAS}$ asserted during refresh = 2 positive edges of CLK.                                                                                                                                                                                                     |  |  |  |  |
|        | $\overline{RAS}$ precharge time = 2 positive edges of CLK.                                                                                                                                                                                                                    |  |  |  |  |
|        | RAS will start from the first positive edge of CLK after GRANTB transitions (DP8422V, DP84T22).                                                                                                                                                                               |  |  |  |  |
| 1, 1   | $\overrightarrow{RAS}$ asserted during refresh = 4 positive edges of CLK.                                                                                                                                                                                                     |  |  |  |  |
|        | RAS precharge time = 3 positive edges of CLK.           RAS will start from the second positive edge of CLK after GRANTB transitions (DP8422V, DP84T22).                                                                                                                      |  |  |  |  |
|        |                                                                                                                                                                                                                                                                               |  |  |  |  |
|        |                                                                                                                                                                                                                                                                               |  |  |  |  |
|        |                                                                                                                                                                                                                                                                               |  |  |  |  |
|        |                                                                                                                                                                                                                                                                               |  |  |  |  |
|        |                                                                                                                                                                                                                                                                               |  |  |  |  |
|        |                                                                                                                                                                                                                                                                               |  |  |  |  |

# 4.0 Port A Access Modes

The DP8420V/21V/22V, DP84T22 have two general purpose access modes. Mode 0 RAS synchronous and Mode 1 RAS asynchronous. One of these modes is selected at programming through the B1 input. A Port A access to DRAM is initiated by two input signals: ADS (ALE) and CS. The access is always terminated by one signal: TAREQ. These input signals should be synchronous to the input clock.

#### 4.1 ACCESS MODE 0

Mode 0, synchronous access, is selected by negating the input B1 during programming (B1=0). To initiate a Mode 0 access, ALE is pulse high and  $\overline{\text{CS}}$  is asserted. If precharge time was met, a refresh of DRAM or a Port B access was not in progress, the  $\overline{\text{RAS}}$  ( $\overline{\text{RASs}}$ ) would be asserted on the

first rising edge of clock. If a refresh or a Port B access is in progress or precharge time is required, the controller will wait until these events have taken place and assert  $\overline{RAS}$  ( $\overline{RASs}$ ) on the next positive edge of clock.

Sometime after the first positive edge of clock after ALE and  $\overline{CS}$  have been asserted, the input  $\overline{AREQ}$  must be asserted. In single port applications, once  $\overline{AREQ}$  is asserted,  $\overline{CS}$  can be negated. On the other hand, ALE can stay asserted several periods of clock; however, ALE must be negated before or during the period of CLK in which  $\overline{AREQ}$  is negated.

The controller samples  $\overline{\text{AREQ}}$  on the every rising edge of clock after  $\overline{\text{DTACK}}$  is asserted. The access will end when  $\overline{\text{AREQ}}$  is sampled negated.

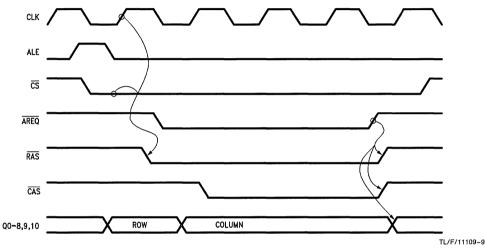


FIGURE 8a. Access Mode 0

1

# 4.0 Port A Access Modes (Continued)

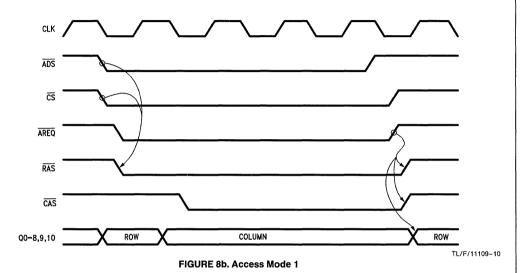
## 4.2 ACCESS MODE 1

Mode 1, asynchronous access, is selected by asserting the input B1 during programming (B1 = 1). This mode allows accesses to start immediately from the access request input,  $\overline{ADS}$ . To initiate a Mode 1 access,  $\overline{CS}$  is asserted followed by  $\overline{ADS}$  asserted. If precharge time was met, a refresh of the DRAM or a Port B access was not in progress, the  $\overline{RAS}$  (RASs) would be asserted from  $\overline{ADS}$  being asserted. If a refresh or Port B access is in progress or precharge time is required, the controller will wait until these events have tak

en place and assert  $\overline{\text{RAS}}$  ( $\overline{\text{RASs}}$ ) from the next rising edge of clock.

When  $\overline{\text{ADS}}$  is asserted or sometime after,  $\overline{\text{AREQ}}$  must be asserted. At this time,  $\overline{\text{ADS}}$  can be negated and  $\overline{\text{AREQ}}$  will continue the access. Also,  $\overline{\text{ADS}}$  can continue to be asserted after  $\overline{\text{AREQ}}$  has been asserted and negated; however, a new access will not start until  $\overline{\text{ADS}}$  is negated and asserted again. When address pipelining is not implemented,  $\overline{\text{ADS}}$  and  $\overline{\text{AREQ}}$  can be tied together.

The access will end when AREQ is negated.

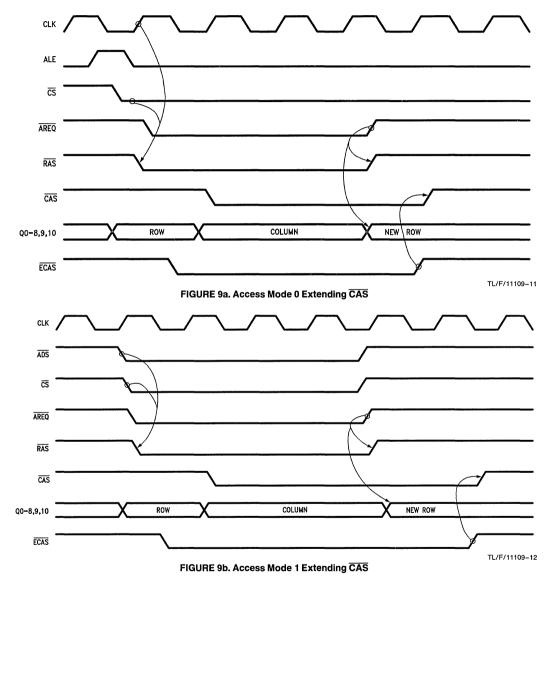


# 4.0 Port A Access Modes (Continued)

## 4.3 EXTENDING CAS WITH EITHER ACCESS MODE

In both access modes, once AREQ is negated, RAS and DTACK if programmed will be negated. If ECAS0 was asserted (0) during programming, CAS (CASs) will be negated

with AREQ. If ECASO was negated (1) during programming, CAS (CASs) will continue to be asserted after RAS has been negated, given that the appropriate ECAS inputs are asserted. This allows a DRAM to have data present on the data out bus while gaining RAS precharge time.

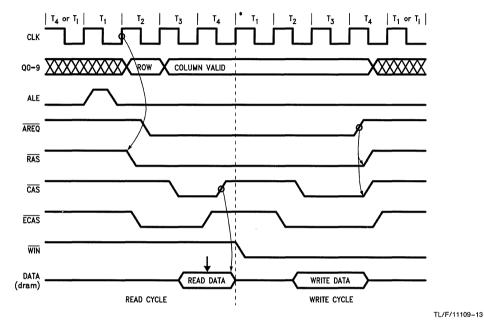


## 4.0 Port A Access Modes (Continued) 4.4 READ-MODIFY-WRITE CYCLES WITH EITHER ACCESS MODE

There are 2 methods by which this chip can be used to do read-modify-write access cycles. The first method involves doing a late write access where the  $\overline{\text{WIN}}$  input is asserted some delay after  $\overline{\text{CAS}}$  is asserted. The second method involves doing a page mode read access followed by a page mode write access with  $\overline{\text{RAS}}$  held low (see *Figure 9c*).

CASn must be toggled using the ECASn inputs and WIN has to be changed from negated to asserted (read to write)

while CAS is negated. This method is better than changing WIN from negated to asserted in a late write access because here a problem may arise with DATA IN and DATA OUT being valid at the same time. This may result in a data line trying to drive two different levels simultaneously. The page mode method of a read-modify-write access allows the user to have transceivers in the system because the data in (read data) is guaranteed to be high impedance during the time the data out (write data) is valid.



\*There may be idle states inserted here by the CPU.

FIGURE 9c. Read-Modify-Write Access Cycle

# 4.0 Port A Access Modes (Continued)

## 4.5 ADDITIONAL ACCESS SUPPORT FEATURES

To support the different modes of accessing, the DP8420V/ 21V/22V, DP84T22 offer other access features. These additional features include: Address Latches and Column Increment (for page/burst mode support), Address Pipelining, and Delay CAS (to allow the user with a multiplexed bus to ensure valid data is present before CAS is asserted).

#### 4.5.1 Address Latches and Column Increment

The Address Latches can be programmed, through programming bit B0. They can be programmed to either latch the address or remain in a fall-through mode. If the address latches are used to latch the address, the controller will function as follows:

In Mode 0, the rising edge of ALE places the latches in fallthrough, once ALE is negated, the address present in the row, column and bank input is latched. In Mode 1, the address latches are in fall through mode until  $\overline{\text{ADS}}$  is asserted.  $\overline{\text{ADS}}$  asserted latches the address.

Once the address is latched, the column address can be incremented with the input COLINC. COLINC can be used for sequential accesses of static column DRAMs. COLINC can also be used with the ECAS inputs to support sequential accesses to page mode DRAMs as shown in *Figure 10*. COLINC should only be asserted when the signal RFIP is negated during an access since this input functions as extended refresh when RFIP is asserted. COLINC must be negated (0) when the address is being latched (ADS falling edge in Mode 1). If COLINC is asserted with all of the bits of the column address asserted (ones), the column address

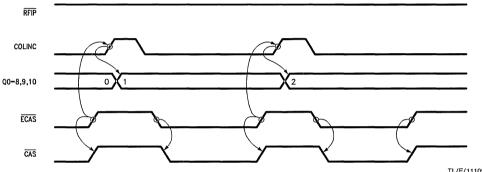


FIGURE 10. Column Increment

TL/F/11109-14

The address latches function differently with the DP8422V, DP84T22. The DP8422V, DP84T22 will latch the address of the currently granted port. If Port A is currently granted, the address will be latched as described in Section 4.5.1. If Port A is not granted, and requests an access, the address will be latched on the first or second positive edge of CLK after GRANTB has been negated depending on the programming bits R0, R1. For Port B, if GRANTB is asserted, the address will be latched with AREQB asserted. If GRANTB is negated, the address will latch on the first or second positive edge of CLK after GRANTB is asserted depending on the programming bits R0, R1.

# 4.0 Port A Access Modes (Continued)

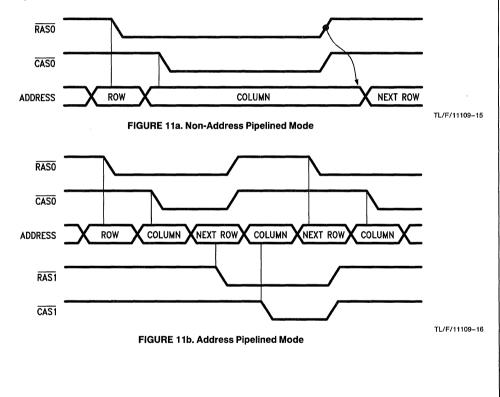
## 4.5.2 Address Pipelining

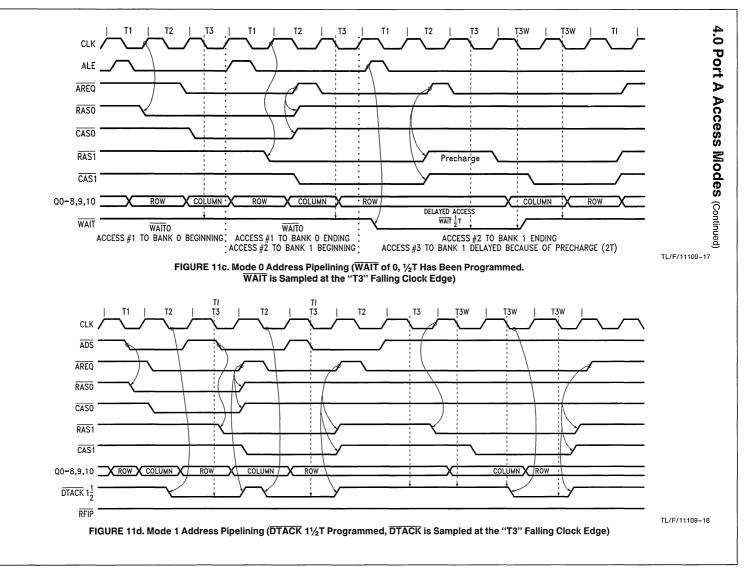
Address pipelining is the overlapping of accesses to different banks of DRAM. If the majority of successive accesses are to a different bank, the accesses can be overlapped. Because of this overlapping, the cycle time of the DRAM accesses are greatly reduced. The DP8420V/21V/22V, DP84T22 can be programmed to allow a new row address to be placed on the DRAM address bus after the column address hold time has been met. At this time, a new access can be initiated with ADS or ALE, depending on the access mode, while AREQ is used to sustain the current access. The DP8422V and DP84T22 support address pipelining for Port A only. This mode cannot be used with page, static column or nibble modes of operations because the DRAM column address is switched back to the row address after CAS is asserted. This mode is programmed through address bit R8 (see Figures 11a and 11b). In this mode, the output WE always functions as RFRQ.

During address pipelining in Mode 0, shown in *Figure 11c*, ALE cannot be pulsed high to start another access until  $\overline{AREQ}$  has been asserted for the previous access for at least one period of CLK. DTACK, if programmed, will be negated once  $\overline{AREQ}$  is negated. WAIT, if programmed to insert wait states, will be asserted once ALE and  $\overline{CS}$  are asserted.

In Mode 1, shown in *Figure 11d*,  $\overline{\text{ADS}}$  can be negated once  $\overline{\text{AREQ}}$  is asserted. After meeting the minimum negated pulse width for  $\overline{\text{ADS}}$ ,  $\overline{\text{ADS}}$  can again be asserted to start a new access.  $\overline{\text{DTACK}}$ , if programmed, will be negated once  $\overline{\text{AREQ}}$  is negated. WAIT, if programmed, will be asserted once  $\overline{\text{ADS}}$  is asserted.

In either mode with either type of wait programmed, the DP8420V/21V/22V, DP84T22 will still delay the access for precharge if sequential accesses are to the same bank or if a refresh takes place.





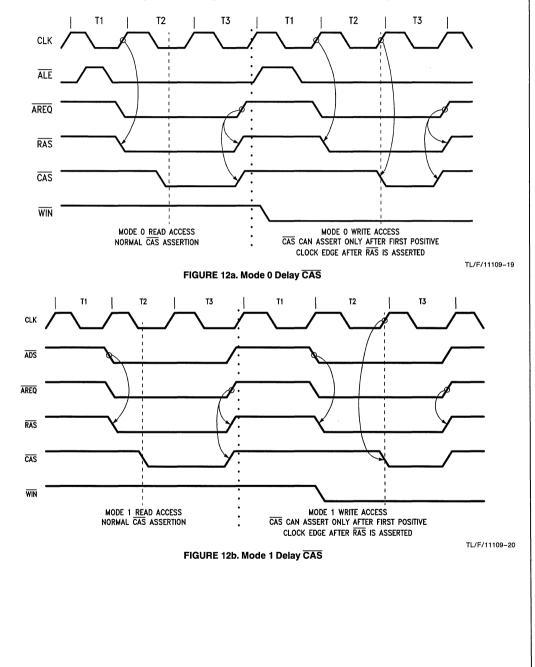
Db8450A-33\Db8451A-33\Db8455A-33\Db84555-52

# 4.0 Port A Access Modes (Continued)

## 4.5.3 Delay CAS during Write Accesses

Address bit C9 asserted during programming will cause  $\overline{CAS}$  to be delayed until the first positive edge of CLK after  $\overline{RAS}$  is asserted when the input  $\overline{WIN}$  is asserted. Delaying  $\overline{CAS}$  during write accesses ensures that the data to be written to DRAM will be setup to  $\overline{CAS}$  asserting as shown in *Figures* 

12a and 12b. If the possibility exists that data still may not be present after the first positive edge of CLK,  $\overline{CAS}$  can be delayed further with the  $\overline{ECAS}$  inputs. If address bit C9 is negated during programming, read and write accesses will be treated the same (with regard to  $\overline{CAS}$ ).



# **5.0 Refresh Options**

The DP8420V/21V/22V, DP84T22 support three refresh control mode options:

1. Automatic Internally Controlled Refresh.

2. Externally Controlled/Burst Refresh.

3. Refresh Request/Acknowledge.

With each of the control modes above, three types of refresh can be performed.

- 1. All RAS Refresh.
- 2. Staggered Refresh.
- 3. Error Scrubbing During All RAS Refresh.

There are three inputs, EXTNDRF,  $\overline{\text{RFSH}}$  and  $\overline{\text{DISRFSH}}$ , and two outputs,  $\overline{\text{RFIP}}$  and  $\overline{\text{RFRQ}}$ , associated with refresh. There are also ten programming bits: RO-1, R9, CO-6 and ECAS0 used to program the various types of refreshing.

Asserting the input EXTNDRF, extends the refresh cycle for a single or multiple integral periods of CLK.

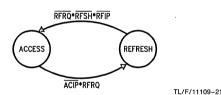
The output  $\overrightarrow{\text{RFIP}}$  is asserted one period of CLK before the first refresh  $\overrightarrow{\text{RAS}}$  is asserted. If an access is currently in progress,  $\overrightarrow{\text{RFIP}}$  will be asserted up to one period of CLK before the first refresh  $\overrightarrow{\text{RAS}}$ , after  $\overrightarrow{\text{AREQ}}$  or  $\overrightarrow{\text{AREQB}}$  is negated for the access (see *Figure 13*).

The DP8420V/21V/22V, DP84T22 will increment the refresh address counter automatically, independent of the refresh mode used. The refresh address counter will be incremented once all the refresh RASs have been negated. In every combination of refresh control mode and refresh type, the DP8420V/21V/22V, DP84T22 is programmed to keep RAS asserted a number of CLK periods. The time values of RAS low during refresh are programmed through programming bits R0 and R1.

#### 5.1 REFRESH CONTROL MODES

#### 5.1.1. Automatic Internal Refresh

The DP8420V/21V/22V, DP84T22 have an internal refresh clock. The period of the refresh clock is generated from the programming bits C0–3. Every period of the refresh clock, an internal refresh request is generated. As long as a DRAM access is not currently in progress and precharge time has been met, the internal refresh request will generate an automatic internal refresh. If a DRAM access is in progress, the DP8420V/21V/22V, DP84T22 on-chip arbitration logic will wait until the access is finished before performing the refresh. The refresh/access arbitration logic can insert a refresh cycle between two address pipelined accesses. However, the refresh arbitration logic can not interrupt an access cycle to perform a refresh. To enable automatic internally controlled refreshes, the input DISRFSH must be negated.



Explanation of Terms

RFRQ = ReFresh ReQuest internal to the DP8420V/21V/22V, DP84T22. RFRQ has the ability to hold off a pending access.

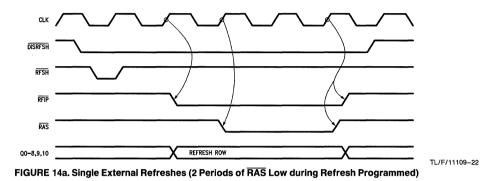
- RFSH = Externally requested ReFreSH
- RFIP = ReFresh in Progress
- ACIP = Port A or Port B (DP8422V and DP84T22 only) ACcess in Progress. This means that either RAS is low for an access or is in the process of transitioning low for an access.

#### FIGURE 13. DP8420V/21V/22V, DP84T22 Access/Refresh Arbitration State Program

#### 5.1.2 Externally Controlled/Burst Refresh

To use externally controlled/burst refresh, the user must disable the automatic internally controlled refreshes by asserting the input DISRFSH. The user is responsible for generating the refresh request by asserting the input  $\overrightarrow{\text{RFSH}}$ . Pulsing  $\overrightarrow{\text{RFSH}}$  low, sets an internal latch, that is used to produce the internal refresh request. The refresh cycle will

take place on the next positive edge of CLK as shown in *Figure 14a*. If an access to DRAM is in progress or precharge time for the last access has not been met, the refresh will be delayed. Since pulsing  $\overline{\text{RFSH}}$  low sets a latch, the user does not have to keep  $\overline{\text{RFSH}}$  low until the refresh starts. When the last refresh  $\overline{\text{RAS}}$  negates, the internal refresh request latch is cleared.



By keeping  $\overline{\text{RFSH}}$  asserted past the positive edge of CLK which ends the refresh cycle as shown in *Figure 14b*, the user will perform another refresh cycle. Using this technique, the user can perform a burst refresh consisting of any number of refresh cycles. Each refresh cycle during a burst refresh will meet the refresh RAS low time and the RAS precharge time (programming bits R0–1).

If the user desires to burst refresh the entire DRAM (all row addresses) he could generate an end of count signal (burst refresh finished) by looking at one of the DP8420V/21V/22V, DP84T22 high address outputs (Q7, Q8, Q9 or Q10) and the  $\overrightarrow{\text{RFIP}}$  output. The Qn outputs function as a decode of how many row addresses have been refreshed (Q7 = 128 refreshes, Q8 = 256 refreshes, Q9 = 512 refreshes, Q10 = 1024 refreshes).

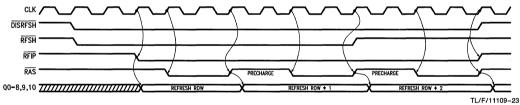


FIGURE 14b. External Burst Refresh (2 Periods of RAS Precharge, 2 Periods of Refresh RAS Low during Refresh Programmed)

#### 5.1.3 Refresh Request/Acknowledge

The DP8420V/21V/22V, DP84T22 can be programmed to output internal refresh requests. When the user programs ECAS0 negated (1) and/or address pipelining mode is selected, the WE output functions as  $\overline{\text{RFRQ}}$ .  $\overline{\text{RFRQ}}$  (WE) will be asserted by one of two events:

First, when the external circuitry pulses low the input RFSH which will request an external refresh.

Second, when the internal refresh clock has expired, which signals that another refresh is needed.

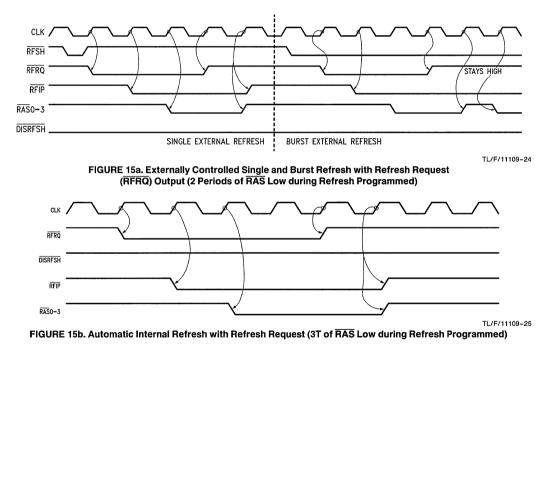
An example of the first case, where an external refresh is requested while  $\overline{\text{RFRQ}}$  is negated (1), is shown in *Figure 15a*. Notice that  $\overline{\text{RFRQ}}$  will be asserted from a positive edge of clock.

On the second case, when the RFRQ is asserted from the expiration of the internal refresh clock, the user has two options:

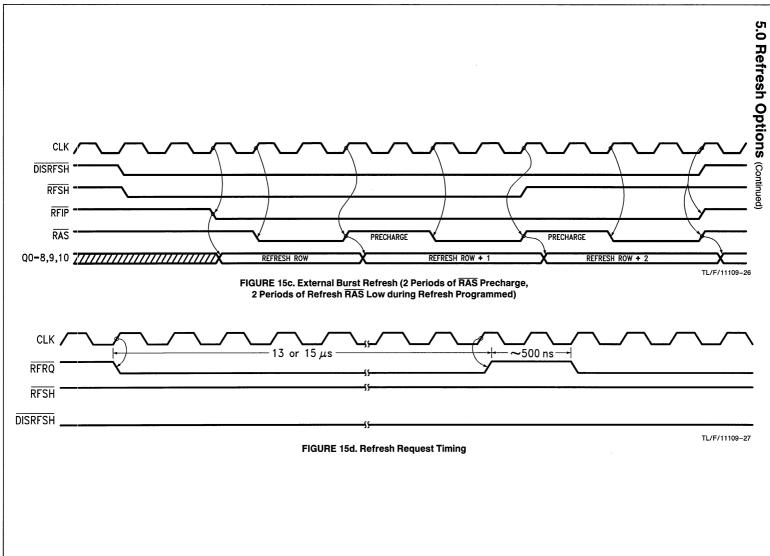
First, if DISRFSH is negated, an automatic internal refresh will take place. See *Figure 15b*.

Second, with DISRFSH asserted, RFRQ will stay asserted until RFSH is pulsed low. This option will cause an externally requested/burst refresh to take place. See *Figure 15c*.

RFRQ will go high and then assert (toggle) if additional periods of the internal refresh clock have expired and neither an externally controlled refresh nor an automatically controlled internal refresh have taken place, see *Figure 15d*. If a time critical event, or long accesses like page/static column mode can not be interrupted, RFRQ pulsing high can be used to increment a counter. This counter can be used to perform a burst refresh of the number of refreshes missed (through the RFSH input).



## DP8420V-33/DP8421V-33/DP8422V-33/DP84T22-25



## **5.2 REFRESH CYCLE TYPES**

Three different types of refresh cycles are available for use. The three different types are mutually exclusive and can be used with any of the three modes of refresh control. The three different refresh cycle types are: all RAS refresh, staggered RAS refresh and error scrubbing during all RAS refresh. In all refresh cycle types, the RAS precharge time is guaranteed: between the previous access RAS ending and the refresh RAS0 starting; between refresh RAS3 ending and access RAS beginning; between burst refresh RAS3.

#### 5.2.1 Conventional RAS Refresh

A conventional refresh cycle causes  $\overline{RAS0}$ -3 to all assert from the first positive edge of CLK after  $\overline{RFIP}$  is asserted as shown in *Figure 16*.  $\overline{RAS0}$ -3 will stay asserted until the number of positive edges of CLK programmed have passed. On the last positive edge,  $\overline{RAS0}$ -3, and  $\overline{RFIP}$  will be negated. This type of refresh cycle is programmed by negating address bit R9 during programming.

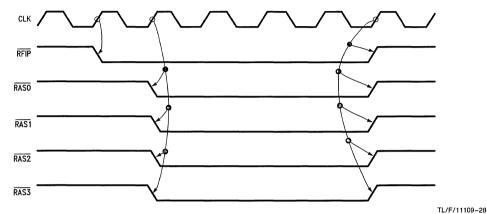
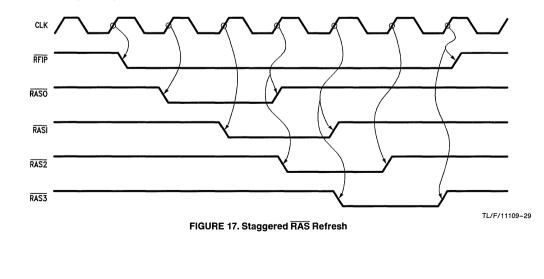


FIGURE 16. Conventional RAS Refresh

#### 5.2.2 Staggered RAS Refresh

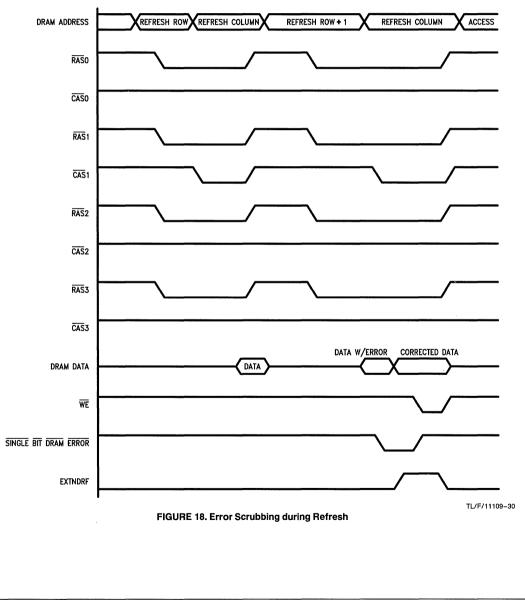
A staggered refresh staggers each RAS or group of RASs by a positive edge of CLK as shown in *Figure 17*. The number of RASs, which will be asserted on each positive edge of CLK, is determined by the RAS, CAS configuration mode programming bits C4–C6. If single RAS outputs are selected during programming, then each RAS will assert on successive positive edges of CLK. If two RAS outputs are selected during programming then RAS on and RAS1 will assert on the first positive edge of CLK after RFIP is asserted. RAS2 and RAS3 will assert on the second positive edge of CLK after RFIP is asserted. If all RAS outputs were selected during programming, all RAS outputs would assert on the first positive edge of CLK after RFIP is asserted. Each RAS or group of RASs will meet the programmed RAS low time and then negate.



## 5.2.3 Error Scrubbing during Refresh

The DP8420V/21V/22V, DP84T22 support error scrubbing during all RAS DRAM refreshes. Error scrubbing during refresh is selected through bits C4–C6 with bit R9 negated during programming. Error scrubbing can not be used with staggered refresh (see Section 8.0). Error scrubbing during refresh allows a CAS or group of CASs to assert during the all RAS refresh as shown in *Figure 18*. This allows data to be read from the DRAM array and passed through an Error Detection And Correction Chip, EDAC. If the EDAC determines that the data contains a single bit error and corrects that error, the refresh cycle can be extended with the input

extend refresh, EXTNDRF, and a read-modify-write operation can be performed by asserting  $\overline{WE}$ . It is the responsibility of the designer to ensure that  $\overline{WE}$  is negated. The DP8422V, DP84T22 have a 24-bit internal refresh address counter that contains the 11 row, 11 column and 2 bank addresses. The DP8420V/21V have a 22-bit internal refresh addresses. The DP8420V/21V have a 22-bit internal refresh addresses. These counters are configured as bank, column, row with the row address as the least significant bits. The bank counter bits are then used with the programming selection to determine which  $\overline{CAS}$  or group of  $\overline{CASs}$ will assert during a refresh.



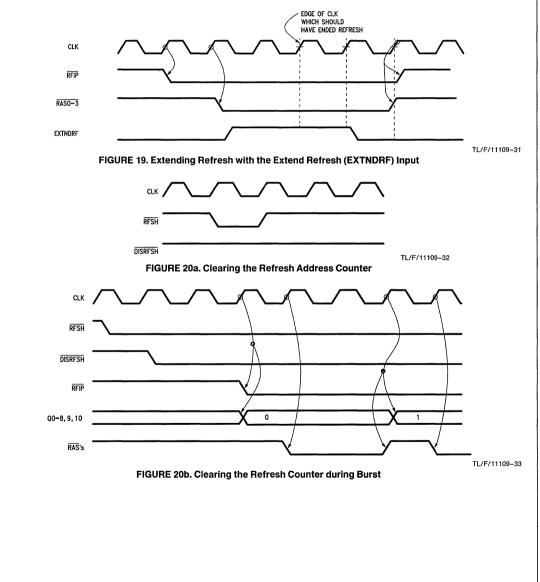
#### 5.3 EXTENDING REFRESH

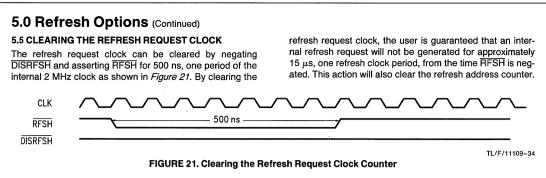
The programmed number of periods of CLK that refresh RASs are asserted can be extended by one or multiple periods of CLK. Only the all RAS (with or without error scrubbing) type of refresh can be extended. To extend a refresh cycle, the input extend refresh, EXTNDRF, must be asserted before the positive edge of CLK that would have negated all the RAS outputs during the refresh cycle and after the positive edge of CLK which starts all RAS outputs during the refresh as shown in *Figure 19*. This will extend the refresh to the next positive edge of CLK and EXTNDRF will be sampled again. The refresh cycle will continue until EXTNDRF is sampled low on a positive edge of CLK.

#### 5.4 CLEARING THE REFRESH ADDRESS COUNTER

The refresh address counter can be cleared by asserting RFSH while DISRFSH is negated as shown in *Figure 20a*.

This can be used prior to a burst refresh of the entire memory array. By asserting  $\overrightarrow{\text{RFSH}}$  one period of CLK before DISRFSH is asserted and then keeping both inputs asserted, the DP8420V/21V/22V, DP84T22 will clear the refresh address counter and then perform refresh cycles separated by the programmed value of precharge as shown in *Figure* 20b. An end-of-count signal can be generated from the Q DRAM address outputs of the DP8420V/21V/22V, DP84T22 and used to negate  $\overrightarrow{\text{RFSH}}$ .





## 6.0 Port A Wait State Support

Wait states allow a CPU's access cycle to be increased by one or multiple CPU clock periods. The wait or ready input is named differently by CPU manufacturers. However, any CPU's wait or ready input is compatible with either the WAIT or DTACK output of the DP8420V/21V/22V, DP84T22. The user determines whether to program WAIT or DTACK (R7) and which value to select for WAIT or DTACK (R2, R3) depending upon the CPU used and where the CPU samples its wait input during an access cycle.

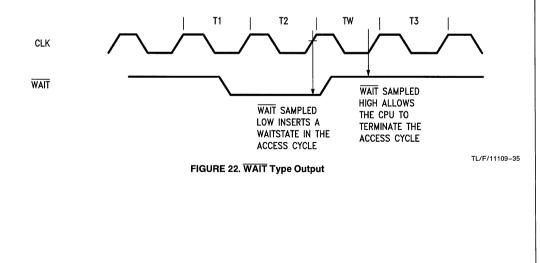
The decision to terminate the CPU access cycle is directly affected by the speed of the DRAMs used. The system designer must ensure that the data from the DRAMs will be present for the CPU to sample or that the data has been written to the DRAM before allowing the CPU access cycle to terminate.

The insertion of wait states also allows a CPU's access cycle to be extended until the DRAM access has taken place. The DP8420V/21V/22V, DP84T22 insert wait states into CPU access cycles due to; guaranteeing precharge time, refresh currently in progress, user programmed wait states, the WAITIN signal being asserted and GRANTB not being valid (DP8422V, DP84T22 only). If one of these events is taking place and the CPU starts an access, the DP8420V/ 21V/22V, DP84T22 will insert wait states into the access cycle, thereby increasing the length of the CPU's access. Once the event has been completed, the DP8420V/21V/ 22V, DP84T22 will allow the access to take place and stop inserting wait states.

There are six programming bits, R2-R7; an input, WAITIN; and an output that functions as WAIT or DTACK.

## 6.1 WAIT TYPE OUTPUT

With the R7 address bit negated during programming, the user selects the WAIT output. As long as WAIT is sampled asserted by the CPU, wait states (extra clock periods) are inserted into the current access cycle as shown in Figure 22. Once WAIT is sampled negated, the access cycle is completed by the CPU. WAIT is asserted at the beginning of a chip selected access and is programmed to negate a number of positive edges and/or negative levels of CLK from the event that starts the access. WAIT can also be programmed to function in page/burst mode applications. Once WAIT is negated during an access, and the ECAS inputs are negated with AREQ asserted, WAIT can be programmed to toggle, following the ECAS inputs. Once AREQ is negated, ending the access, WAIT will stay negated until the next chip selected access. For more details about WAIT Type Output, see Application Note AN-773.



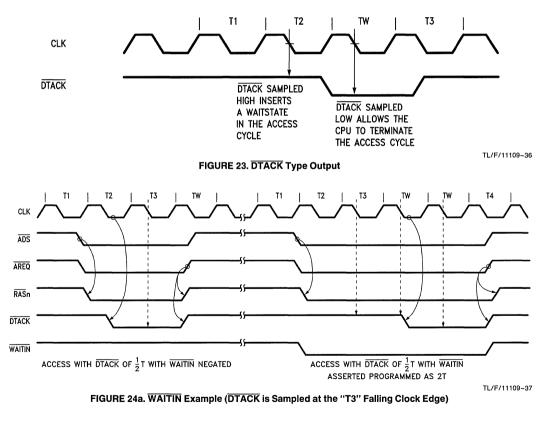
# 6.0 Port A Wait State Support (Continued)

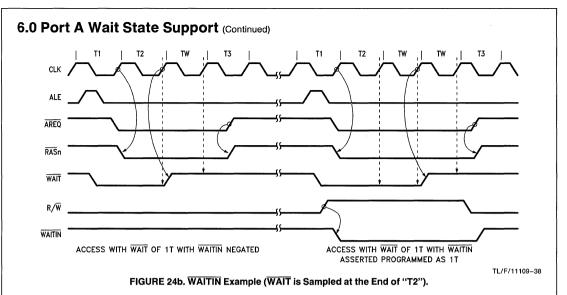
## 6.2 DTACK TYPE OUTPUT

With the R7 address bit asserted during programming, the user selects the DTACK type output. As long as DTACK is sampled negated by the CPU, wait states are inserted into the current access cycle as shown in Figure 23. Once DTACK is sampled asserted, the access cycle is completed by the CPU. DTACK, which is normally negated, is programmed to assert a number of positive edges and/or negative levels from the event that starts RAS for the access. DTACK can also be programmed to function during page/ burst mode accesses. Once DTACK is asserted and the ECAS inputs are negated with AREQ asserted. DTACK can be programmed to negate and assert from the ECAS inputs toggling to perform a page/burst mode operation. Once AREQ is negated, ending the access, DTACK will be negated and stays negated until the next chip selected access. For more details about DTACK type output, see Application Note AN-773.

#### 6.3 DYNAMICALLY INCREASING THE NUMBER OF WAIT STATES

The user can increase the number of positive edges of CLK before DTACK is asserted or WAIT is negated. With the input WAITIN asserted, the user can delay DTACK asserting or WAIT negating either one or two more positive edges of CLK. The number of edges is programmed through address bit R6. If the user is increasing the number of positive edges in a delay that contains a negative level, the positive edges will be met before the negative level. For example if the user programmed DTACK of 1/2T, asserting WAITIN, programmed as 2T, would increase the number of positive edges resulting in DTACK of 21/3T as shown in Figure 24a. Similarly, WAITIN can increase the number of positive edges in a page/burst access. WAITIN can be permanently asserted in systems requiring an increased number of wait states. WAITIN can also be asserted and negated, depending on the type of access. As an example, a user could invert the WRITE line from the CPU and connect the output to WAITIN. This could be used to perform write accesses with 1 wait state and read accesses with 2 wait states as shown in Figure 24b.



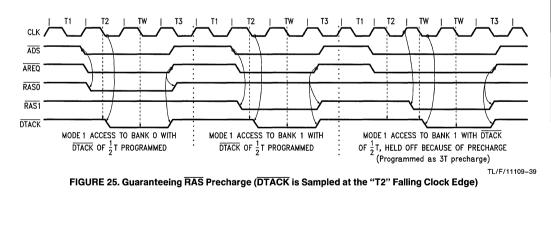


#### 6.4 GUARANTEEING RAS LOW TIME AND RAS PRECHARGE TIME

The DP8420V/21V/22V, DP84T22 will guarantee  $\overline{\text{RAS}}$  precharge time between accesses; between refreshes; and between access and refreshes. The programming bits R0 and R1 are used to program combinations of  $\overline{\text{RAS}}$  precharge time and  $\overline{\text{RAS}}$  low time referenced by positive edges of CLK.  $\overline{\text{RAS}}$  low time is programmed for refreshes only. During an access, the system designer guarantees the time  $\overline{\text{RAS}}$  is asserted through the DP8420V/21V/22V, DP84T22 wait logic. Since inserting wait states into an access increases the length of the CPU signals which are used to create  $\overline{\text{ADS}}$  or ALE and  $\overline{\text{AREQ}}$ , the time that  $\overline{\text{RAS}}$  is asserted.

The precharge time is also guaranteed by the DP8420V/ 21V/22V, DP84T22. Each RAS output has a separate posi-

tive edge of CLK counter.  $\overline{\text{AREQ}}$  is negated setup to a positive edge of CLK to terminate the access. That positive edge is 1T. The next positive edge is 2T.  $\overline{\text{RAS}}$  will not be asserted until the programmed number of positive edges of CLK have passed as shown in *Figure 25*. Once the programmed precharge time has been met,  $\overline{\text{RAS}}$  will be asserted from the positive edge of CLK. However, since there is a precharge counter per  $\overline{\text{RAS}}$ , an access using another  $\overline{\text{RAS}}$  will not be delayed. Precharge time before a refresh is always referenced from the access  $\overline{\text{RAS}}$  negating before  $\overline{\text{RAS}}$  of the refresh asserting. After a refresh, precharge time is referenced from  $\overline{\text{RAS}}$  angating, for the refresh, to the access  $\overline{\text{RAS}}$  asserting.

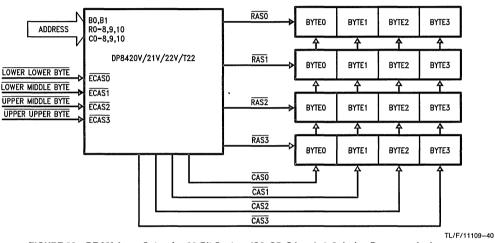


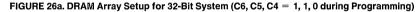
# 7.0 $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ Configuration Modes

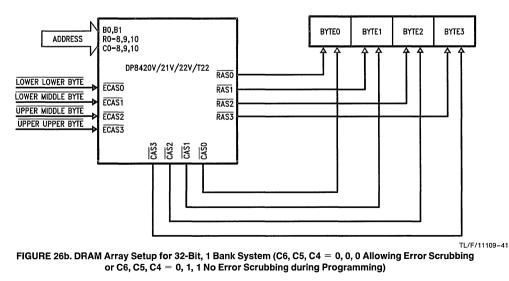
The DP8420V/21V/22V, DP84T22 allow the user to configure the DRAM array to contain one, two or four banks of DRAM. Depending on the functions used, certain considerations must be used when determining how to set up the DRAM array, Programming address bits C4, C5 and C6 along with bank selects, B0-1, and CAS enables, ECAS0-3, determine which RAS or group of RASs and which CAS or group of CASs will be asserted during an access. Different memory schemes are described. The DP8420V/21V/ 22V, DP84T22 is specified driving a heavy load of 72 DRAMs, representing four banks of DRAM with 16-bit words and 2 parity bits. The DP8420V/21V/22V, DP84T22 can drive more than 72 DRAMs, but the AC timing must be increased. Since the RAS and CAS outputs are configurable. all RAS and CAS outputs should be used for the maximum amount of drive.

#### 7.1 BYTE WRITING

By selecting a configuration in which all  $\overline{CAS}$  outputs are selected during an access, the  $\overline{ECAS}$  inputs enable a single or group of  $\overline{CAS}$  outputs to select a byte (or bytes) in a word size of up to 32 bits. In this case, the  $\overline{RAS}$  outputs are used to select which of up to 4 banks is to be used as shown in *Figures 26a* and *26b*. In systems with a word size of 16 bits, the byte enables can be gated with a high order address bit to produce four byte enables which gives an equivalent to 8 banks of 16-bit words as shown in *Figure 26d*. If less memory is required, each  $\overline{CAS}$  should be used to drive each nibble in the 16-bit word as shown in *Figure 26c*.







# 7.0 RAS and CAS Configuration Modes (Continued)

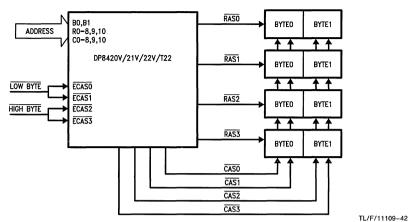
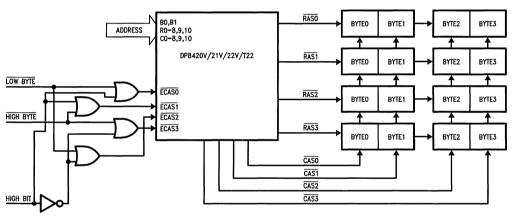


FIGURE 26c. DRAM Array Setup for 16-Bit System (C6, C5, C4 = 1, 1, 0 during Programming)



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FIGURE 26d. 8 Bank DRAM Array for 16-Bit System (C6, C5, C4 = 1, 1, 0 during Programming)

# DP8420V-33/DP8421V-33/DP8422V-33/DP84T22-25

# 7.0 RAS and CAS Configuration Modes (Continued)

#### 7.2 MEMORY INTERLEAVING

Memory interleaving allows the cycle time of DRAMs to be reduced by having sequential accesses to different memory banks. Since the DP8420V/21V/22V, DP84T22 have separate precharge counters per bank, sequential accesses will not be delayed if the accessed banks use different  $\overline{\text{RAS}}$ outputs. To ensure different  $\overline{\text{RAS}}$  outputs will be used, a mode is selected where either one or two  $\overline{\text{RAS}}$  outputs will be asserted during an access. The bank select or selects, B0 and B1, are then tied to the least significant address bits, causing a different group of  $\overline{\text{RAS}}$  to assert during each sequential access as shown in *Figure 27*. In this figure there should be at least one clock period of all  $\overline{\text{RAS}}$ 's negated between different  $\overline{\text{RAS}}$ 's being asserted to avoid the condition of a  $\overline{\text{CAS}}$  before  $\overline{\text{RAS}}$  refresh cycle.

## 7.3 ADDRESS PIPELINING

Address pipelining allows several access RASs to be asserted at once. Because RASs can overlap, each bank requires either a mode where one RAS and one CAS are used per bank as shown in Figure 28a or where two RASs and two CASs are used per bank as shown in Figure 28b. Byte writing can be accomplished in a 16-bit word system if two RASs and two CASs are used per bank. In other systems, WEs (or external gating on the CAS outputs) must be used to perform byte writing. If WEs are used separate data in and data out buffers must be used. If the array is not laved out this way, a CAS to a bank can be low before RAS, which will cause a refresh of the DRAM, not an access. To take full advantage of address pipelining, memory interleaving is used. To memory interleave, the least significant address bits should be tied to the bank select inputs to ensure that all "back to back" sequential accesses are not delayed, since different memory banks are accessed.

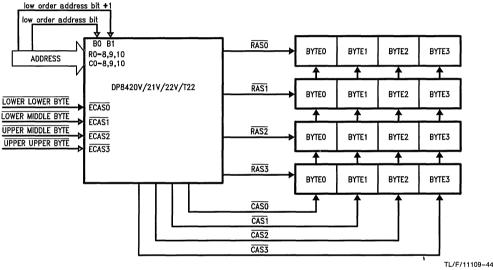
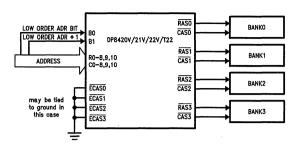


FIGURE 27. Memory Interleaving (C6, C5, C4 = 1, 1, 0 during Programming)

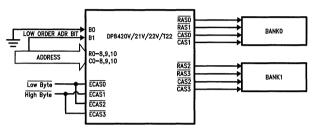
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# 7.0 RAS and CAS Configuration Modes (Continued)



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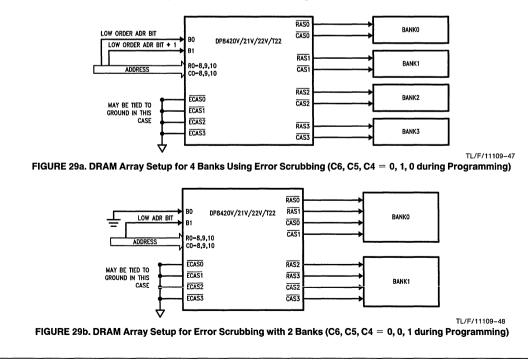
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#### 7.4 ERROR SCRUBBING

In error scrubbing during refresh, the user selects one, two or four  $\overline{\text{PAS}}$  and  $\overline{\text{CAS}}$  outputs per bank. When performing error detection and correction, memory is always accessed

as words. Since the CAS signals are not used to select individual bytes, the ECAS inputs can be tied low as shown in *Figures 29a* and *29b*.



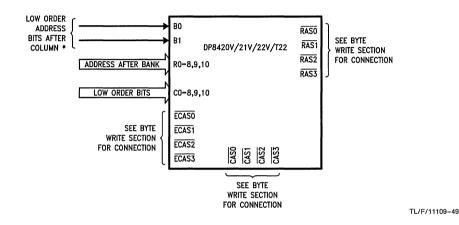
# DP8420V-33/DP8421V-33/DP8422V-33/DP84T22-25

# 7.0 RAS and CAS Configuration Modes (Continued)

#### 7.5 PAGE/BURST MODE

In a static column, page or burst mode system, the least significant bits must be tied to the column address in order to ensure that the page/burst accesses are to sequential memory addresses, as shown in *Figure 30*. In a nibble mode system, the least significant bits must be tied to the highest column and row address bits in order to ensure that sequential address bits are the "nibble" bits for nibble mode accesses (*Figure 30*). The ECAS inputs may then be tog-gled with the DP8420V/21V/22V's, DP84T22's address

latches in fall-through mode, while  $\overline{\text{AREQ}}$  is asserted. The  $\overline{\text{ECAS}}$  inputs can also be used to select individual bytes. When using nibble mode DRAMS, the third and fourth address bits can be tied to the bank select inputs to perform memory interleaving. In page or static column modes, the two address bits after the page size can be tied to the bank select inputs to select a new bank if the page size is exceeded.



\*See table below for row, column & bank address bit map. A0, A1 are used for byte addressing in this example.

| Addresses         | Nibble Mode*              | Page Mode/Static Column Mode Page Size |                           |                         |                |  |  |  |  |
|-------------------|---------------------------|----------------------------------------|---------------------------|-------------------------|----------------|--|--|--|--|
| Audiesses         | NIBBLE MODE               | 256 Bits/Page 512 Bits/Page            |                           | 1024 Bits/Page          | 2048 Bits/Page |  |  |  |  |
| Column<br>Address | C9,R9 = A2,A3<br>C0-8 = X | C0-7 = A2-9<br>C8-10 = X               | C0-8 = A2-10<br>C9,10 = X | C0-9 = A2-11<br>C10 = X | C0-10 = A2-12  |  |  |  |  |
| Row<br>Address    | x                         | x                                      | x                         | х                       | ×              |  |  |  |  |
| B0<br>B1          | A4<br>A5                  | A10<br>A11                             | A11<br>A12                | A12<br>A13              | A13<br>A14     |  |  |  |  |

Assume that the least significant address bits are used for byte addressing. Given a 32-bit system A0,A1 would be used for byte addressing.

X = DON'T CARE, the user can do as he pleases.

\*Nibble mode values for R and C assume a system using 1 Mbit DRAMs.

FIGURE 30. Page, Static Column, Nibble Mode System

# 8.0 Test Mode

Staggered refresh in combination with the error scrubbing mode places the DP8420V/21V/22V, DP84T22 in test mode. In this mode, the 24-bit refresh counter is divided into a 13-bit and 11-bit counter. During refreshes both counters are incremented to reduce test time.

## 9.0 DRAM Critical Timing Parameters

The two critical timing parameters, shown in *Figure 31*, that must be met when controlling the access timing to a DRAM are the row address hold time,  $t_{RAH}$ , and the column address setup time,  $t_{ASC}$ . Since the DP8420V/21V/22V, DP84T22 contain a precise internal delay line, the values of these parameters can be selected at programming time. These values will also increase and decrease if DELCLK varies from 2 MHz.

## 9.1 PROGRAMMABLE VALUES OF tRAH AND TASC

The DP8420V/21V/22V, DP84T22 allow the values of  $t_{\rm RAH}$  and  $t_{\rm ASC}$  to be selected at programming time. For each parameter, two choices can be selected.  $t_{\rm RAH}$ , the row address hold time, is measured from RAS asserted to the row address starting to change to the column address. The two choices for  $t_{\rm RAH}$  are 15 ns and 25 ns, programmable through address bit C8.

 $t_{ASC}$ , the column address setup time, is measured from the column address valid to  $\overline{CAS}$  asserted. The two choices for  $t_{ASC}$  are 0 ns and 10 ns, programmable through address bit C7.

## 9.2 CALCULATION OF tRAH AND TASC

There are two clock inputs to the DP8420V/21V/22V, DP84T22. These two clocks, DELCLK and CLK can either be tied together to the same clock or be tied to different clocks running asynchronously at different frequencies.

The clock input, DELCLK, controls the internal delay line and refresh request clock. DELCLK should be a multiple of 2 MHz. If DELCLK is not a multiple of 2 MHz,  $t_{RAH}$  and  $t_{ASC}$  will change. The new values of  $t_{RAH}$  and  $t_{ASC}$  can be calculated by the following formulas:

If  $t_{\rm RAH}$  was programmed to equal 15 ns then  $t_{\rm RAH}=15^{*}(((\rm DELCLK\ Divisor)^{*}\ 2\ MHz/(\rm DELCLK\ Frequency))-1)$  + 15 ns.

If  $t_{\rm RAH}$  was programmed to equal 25 ns then  $t_{\rm RAH}=25^{*}(((\rm DELCLK\ Divisor)^{*}\ 2\ MHz/(\rm DELCLK\ Frequency))-1)$   $+\ 25$  ns.

If  $t_{ASC}$  was programmed to equal 0 ns then  $t_{ASC}=12.5^{\ast}$  ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 12.5 ns.

If  $t_{ASC}$  was programmed to equal 10 ns then  $t_{ASC}$  = 22.5\* ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 22.5 ns.

Since the values of  $\underline{t_{RAH}}$  and  $\underline{t_{ASC}}$  are increased or decreased, the time to  $\overline{CAS}$  asserted will also increase or decrease. These parameters can be adjusted by the following formula:

 $\begin{array}{l} \mbox{Delay to } \overline{\mbox{CAS}} = \mbox{Actual Spec.} + \mbox{Actual t}_{RAH} - \\ \mbox{Programmed t}_{RAH} + \mbox{Actual t}_{ASC} - \mbox{Programmed t}_{ASC}. \end{array}$ 

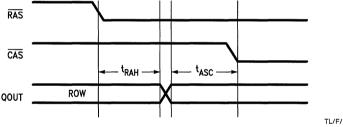


FIGURE 31. t<sub>RAH</sub> and t<sub>ASC</sub>

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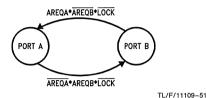
# 10.0 Dual Accessing (DP8422V, DP84T22)

The DP8422V, DP84T22 has all the functions previously described. In addition to those features, the DP8422V, DP84T22 also has the capabilities to arbitrate among refresh, Port A and a second port, Port B. This allows two CPUs to access a common DRAM array. DRAM refresh has the highest priority followed by the currently granted port. The ungranted port has the lowest priority. The last granted port will continue to stay granted even after the access has terminated, until an access request is received from the ungranted port (see *Figure 32a*). The dual access configuration assumes that both Port A and Port B are synchronous to the system clock. If they are not synchronized (Ex. By running the access requests through several Flip-Flops, see *Figure 34a*).

#### **10.1 PORT B ACCESS MODE**

Port B accesses are initiated from a single input,  $\overline{AREQB}$ . When  $\overline{AREQB}$  is asserted, an access request is generated. If GRANTB is asserted and a refresh is not taking place or precharge time is not required,  $\overline{RAS}$  will be asserted when  $\overline{AREQB}$  is asserted. Once  $\overline{AREQB}$  is asserted, it must stay asserted until the access is over.  $\overline{AREQB}$  negated, negates  $\overline{RAS}$  as shown in *Figure 32b*. Note that if  $\overline{ECASO} = 1$  during programming the  $\overline{CAS}$  outputs may be held asserted (beyond  $\overline{RAS}$ n negating) by continuing to assert the appropriate  $\overline{ECASn}$  inputs (the same as Port A accesses). If Port B is not granted, the access will begin on the first or second positive edge of CLK after GRANTB is asserted (See R0, R1 programming bit definitions) as shown in *Figure 32c*, assuming that Port A is not accessing the DRAM ( $\overline{CS}$ ,  $\overline{ADS}/$ ALE and  $\overline{AREQ}$ ) and  $\overline{RAS}$  precharge for the particular bank has completed. It is important to note that for GRANTB to transition to Port B, Port A must **not** be requesting an access at a rising clock edge (or locked) and Port B must be requesting an access at that rising clock edge. Port A can request an access through  $\overline{CS}$  and  $\overline{ADS}/ALE$  or  $\overline{CS}$  and  $\overline{ADS}/ALE$  or  $\overline{CS}$  and  $\overline{ADS}/ALE$  or  $\overline{CS}$  and  $\overline{ADS}/ALE$  become asserted before  $\overline{AREQ}$  from the previous access is negated, Port A will retain GRANTB = 0 whether  $\overline{AREQB}$  is asserted or not.

Since there is no chip select for Port B, AREQB must incorporate this signal. This mode of accessing is similar to Mode 1 accessing for Port A.

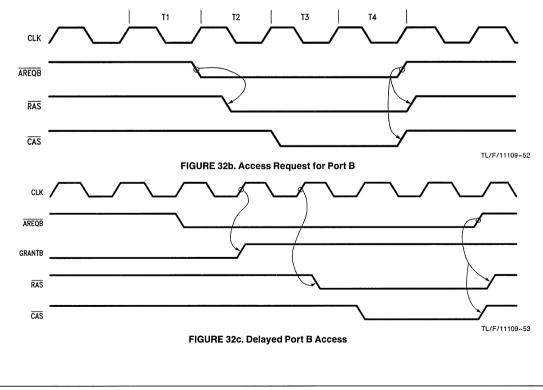


#### Explanation of Terms

| AREQA = | Chip Selected access request from Port A |
|---------|------------------------------------------|
| AREQB = | Chip Selected access request from Port B |

LOCK = Externally controlled LOCKing of the Port

that is currently GRANTed. FIGURE 32a. DP8422V, DP84T22 Port A/Port B Arbitration State Diagram. This arbitration may take place during the "ACCESS" or "REFRESH" state (see *Figure 13*).



# 10.0 Dual Accessing (DP8422V, DP84T22) (Continued)

## **10.2 PORT B WAIT STATE SUPPORT**

Advanced transfer acknowledge for Port B,  $\overline{\text{ATACKB}}$ , is used for wait state support for Port B. This output will be asserted when  $\overline{\text{RAS}}$  for the Port B access is asserted, as shown in *Figures 33a* and *33b*. Once asserted, this output will stay asserted until  $\overline{\text{AREQB}}$  is negated. With external logic,  $\overline{\text{ATACKB}}$  can be made to interface to any CPU's wait input as shown in *Figure 33c*.

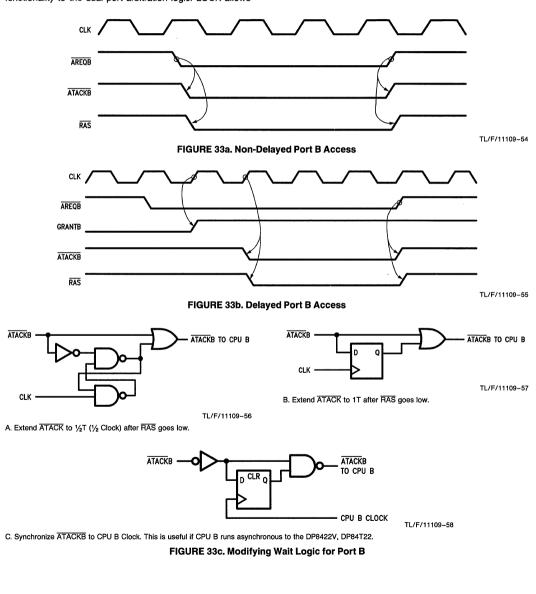
# 10.3 COMMON PORT A AND PORT B DUAL PORT FUNCTIONS

An input, LOCK, and an output, GRANTB, add additional functionality to the dual port arbitration logic. LOCK allows

Port A or Port B to lock out the other port from the DRAM. When a Port is locked out of the DRAM, wait states will be inserted into its access cycle until it is allowed to access memory. GRANTB is used to multiplex the input control signals and addresses to the DP8422V, DP84T22.

#### 10.3.1 GRANTB Output

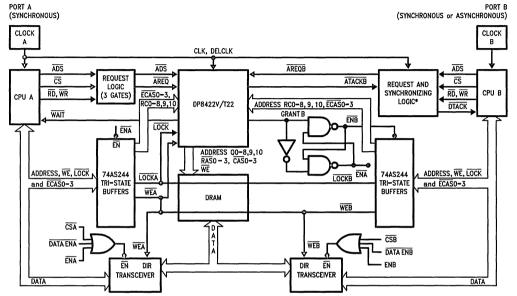
The output GRANTB determines which port has current access to the DRAM array. GRANTB asserted signifies Port B has access. GRANTB negated signifies Port A has access to the DRAM array.



## 10.0 Dual Accessing (DP8422V, DP84T22) (Continued)

Since the DP8422V, DP84T22 has only one set of address inputs, the signal is used, with the addition of buffers, to allow the currently granted port's addresses to reach the DP8422V, DP84T22. The signals which need to be bufferred are R0-10, C0-10, B0-1, ECAS0-3, WE, and LOCK. All other inputs are not common and do not have to be buffered as shown in *Figure 34a*. If a Port, which is not

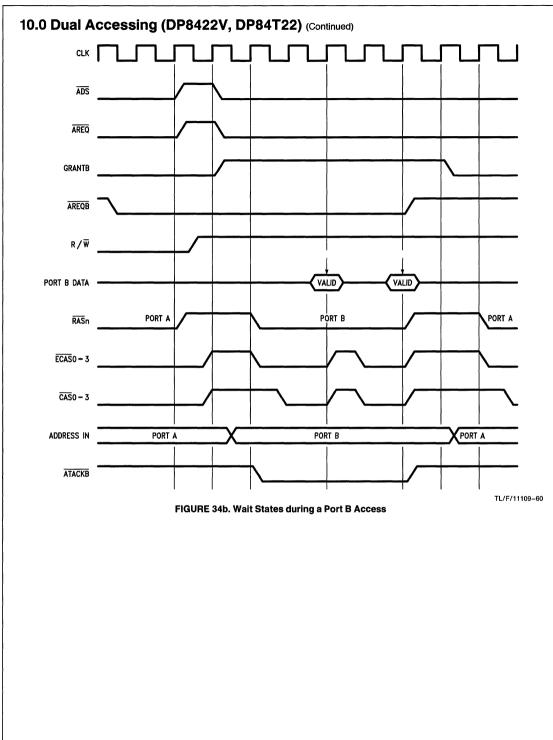
currently granted, tries to access the DRAM array, the GRANTB output will transition from a rising clock edge from AREQ or AREQB negating and will precede the RAS for the access by one or two clock periods. GRANTB will then stay in this state until the other port requests an access and the currently granted port is not accessing the DRAM as shown in *Figure 34b*.



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\*If Port B is synchronous the Request Synchronizing logic will not be required.

#### FIGURE 34a. Dual Accessing with the DP8422V, DP84T22 (System Block Diagram)



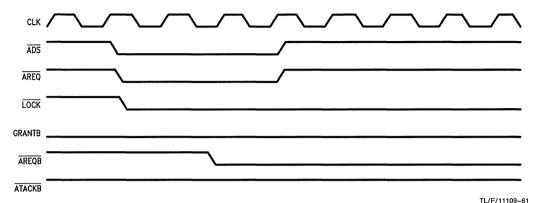
DP8420V-33/DP8421V-33/DP8422V-33/DP84T22-25

## 10.0 Dual Accessing (DP8422V, DP84T22) (Continued)

## 10.3.2 LOCK Input

When the  $\overline{\text{LOCK}}$  input is asserted, the currently granted port can "lock out" the other port through the insertion of wait states to that port's access cycle.  $\overline{\text{LOCK}}$  does not disable

refreshes, it only keeps GRANTB in the same state even if the other port requests an access, as shown in *Figure 35*. LOCK can be used by either port.



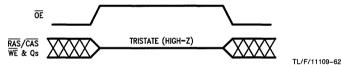
#### FIGURE 35. LOCK Function

#### 10.4 TRI-STATE OUTPUTS (DP84T22V Only)

This version is a metal option on the DP8420V/21V/22V-33 DRAM controllers. It comes in a 84-pin PLCC and implements TRI-STATE output capabilities. It has only one extra pin  $\overline{OE}$ . When  $\overline{OE}$  is asserted the output buffers are enabled allowing the DRAM controller to interface to the DRAM array.

If  $\overline{OE}$  is negated, the output buffers are at TRI-STATE (high-Z) making the board level circuit testing easier. The time penalty for the TRI-STATE option has been minimized making this option attractive to high performance designs. This part is functionally compatible to the DP8422A-20, -25.





If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Temperature under Bias Storage Temperature 0°C to +70°C -65°C to +150°C All Input or Output Voltage with Respect to GND Power Dissipation @ 20 MHz ESD Rating to be determined.

-0.5V to +7V 0.5W

| <b>12.0 DC Electrical Characteristics</b> $T_A = 0^{\circ}C$ to $+70^{\circ}C$ , $V_{CC} = 5V \pm 10^{\circ}$ , $GND = 0V$ |
|----------------------------------------------------------------------------------------------------------------------------|
|----------------------------------------------------------------------------------------------------------------------------|

| Symbol            | Parameter                 | Conditions                                                                                         | Min                   | Тур | Max                   | Units |
|-------------------|---------------------------|----------------------------------------------------------------------------------------------------|-----------------------|-----|-----------------------|-------|
| VIH               | Logical 1 Input Voltage   | Tested with a Limited<br>Functional Pattern                                                        | 2.0                   |     | V <sub>CC</sub> + 0.5 | v     |
| VIL               | Logical 0 Input Voltage   | Tested with a Limited<br>Functional Pattern                                                        | -0.5                  |     | 0.8                   | v     |
| V <sub>OH1</sub>  | Q and WE Outputs          | I <sub>OH</sub> = −10 mA                                                                           | V <sub>CC</sub> 1.0   |     |                       | v     |
| V <sub>OL1</sub>  | Q and WE Outputs          | I <sub>OL</sub> = 10 mA                                                                            |                       |     | 0.5                   | v     |
| V <sub>OH2</sub>  | All Outputs except Qs, WE | I <sub>OH</sub> = −3 mA                                                                            | V <sub>CC</sub> - 1.0 |     |                       | v     |
| V <sub>OL2</sub>  | All Outputs except Qs, WE | $I_{OL} = 3 \text{ mA}$                                                                            |                       |     | 0.5                   | v     |
| l <sub>IN</sub>   | Input Leakage Current     | $V_{IN} = V_{CC} \text{ or } GND$                                                                  | -10                   |     | 10                    | μΑ    |
| IL ML             | ML Input Current (Low)    | V <sub>IN</sub> = GND                                                                              |                       |     | 200                   | μΑ    |
| ICC1              | Standby Current           | CLK at 8 MHz ( $V_{IN} = V_{CC}$ or GND)                                                           |                       | 6   | 15                    | mA    |
| ICC1              | Standby Current           | CLK at 20 MHz ( $V_{IN} = V_{CC}$ or GND)                                                          |                       | 8   | 17                    | mA    |
| I <sub>CC1</sub>  | Standby Current           | CLK at 25 MHz ( $V_{IN} = V_{CC}$ or GND)                                                          |                       | 10  | 20                    | mA    |
| I <sub>CC2</sub>  | Supply Current            | CLK at 8 MHz (Inputs Active)<br>(I <sub>LOAD</sub> = 0) (V <sub>IN</sub> = V <sub>CC</sub> or GND) |                       | 20  | 40                    | mA    |
| I <sub>CC2</sub>  | Supply Current            | CLK at 20 MHz (Inputs Active)<br>( $I_{LOAD} = 0$ ) ( $V_{IN} = V_{CC}$ or GND)                    |                       | 40  | 75                    | mA    |
| I <sub>CC2</sub>  | Supply Current            | CLK at 25 MHz (Inputs Active) ( $I_{LOAD} = 0$ ) ( $V_{IN} = V_{CC}$ or GND)                       |                       | 50  | 95                    | mA    |
| lozh              | Leakage Current           | $V_{CC} = Max$<br>$V_O = V_{CC} - 1.0V$                                                            |                       |     | 10                    | μA    |
| I <sub>OZL</sub>  | Leakage Current           | $V_{CC} = Max$<br>$V_{O} = 0.5V$                                                                   |                       |     | -10                   | μΑ    |
| C <sub>IN</sub> * | Input Capacitance         | f <sub>IN</sub> at 1 MHz                                                                           |                       |     | 10                    | pF    |

\*CIN is not 100% tested.

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Input pulse 0V to 3V; tR = tF = 2.5 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.4V for High and 0.8V for Low. Note 3: AC Production testing is done at 50 pF.

## **13.0 AC Timing Parameters**

Two speed selections are given, the DP8420V/21V/22V-33 and the DP84T22-25. The differences between the two parts are the maximum operating frequencies of the input CLKs and the maximum delay specifications. Low frequency applications may use the "-33" part to gain improved timing.

The AC timing parameters are grouped into sectional numbers as shown below. These numbers also refer to the timing diagrams.

- 1-36 Common parameters to all modes of operation
- 50–56 Difference parameters used to calculate; RAS low time, RAS precharge time, CAS high time and CAS low time
- 100-121 Common dual access parameters used for Port B accesses and inputs and outputs used only in dual accessing
- 200-212 Refresh parameters

- 300-315 Mode 0 access parameters used in both single and dual access applications
- 400-416 Mode 1 access parameters used in both single and dual access applications
- 450-455 Special Mode 1 access parameters which supersede the 400-416 parameters when dual accessing
- 500-506 Programming parameters

Unless otherwise stated  $V_{CC}=5.0V~\pm10\%,~0< T_A<70^\circ C,$  the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except
- $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or
- $C_H = 50 \text{ pF}$  loads on all outputs except
- $C_H = 125 \text{ pF}$  loads on  $\overline{RAS0}-3$  and  $\overline{CAS0}-3$  and
- $C_H = 380 \text{ pF}$  loads on Q0–8, 9, 10 and  $\overline{WE}$ .

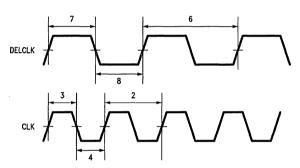


FIGURE 36. Clock, DELCLK Timing

TL/F/11109-63

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C  $< T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{\text{WE}}$ ; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380$  pF loads on Q0-8, 9, 10 and  $\overline{WE}.$

|        |                 |                                                                                                 | DP84 | 420V/21 | V/22V | -33 | DP84T22-25 |     |     |     |  |
|--------|-----------------|-------------------------------------------------------------------------------------------------|------|---------|-------|-----|------------|-----|-----|-----|--|
| Number | Symbol          | Common Parameter<br>Description                                                                 | С    | L       | C     | н   | С          | L   | C   | Я   |  |
|        |                 | Decomption                                                                                      | Min  | Max     | Min   | Max | Min        | Max | Min | Max |  |
| 1      | fCLK            | CLK Frequency                                                                                   | 0    | 33      | 0     | 33  | 0          | 25  | 0   | 25  |  |
| 2      | tCLKP           | CLK Period                                                                                      | 30   |         | 30    |     | 30         |     | 30  |     |  |
| 3, 4   | tCLKPW          | CLK Pulse Width                                                                                 | 12   |         | 12    |     | 12         |     | 12  |     |  |
| 5      | fDCLK           | DELCLK Frequency                                                                                | 6    | 20      | 6     | 20  | 6          | 20  | 6   | 20  |  |
| 6      | tDCLKP          | DELCLK Period                                                                                   | 50   | 166     | 50    | 166 | 50         | 166 | 50  | 166 |  |
| 7, 8   | tDCLKPW         | DELCLK Pulse Width                                                                              | 12   |         | 12    |     | 12         |     | 12  |     |  |
| 9a     | tPRASCAS0       | RAS Asserted to CAS Asserted<br>(tRAH = 15 ns, tASC = 0 ns)                                     | 30   |         | 30    |     | 30         |     | 30  |     |  |
| 9b     | tPRASCAS1       | $\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)          | 40   |         | 40    |     | 40         |     | 40  |     |  |
| 9c     | tPRASCAS2       | $(\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)          | 40   |         | 40    |     | 40         |     | 40  |     |  |
| 9d     | tPRASCAS3       | $(\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)         | 50   |         | 50    |     | 50         |     | 50  |     |  |
| 10a    | tRAH            | Row Address Hold Time (tRAH = $15$ )                                                            | 15   |         | 15    |     | 15         |     | 15  |     |  |
| 10b    | tRAH            | Row Address Hold Time (tRAH = $25$ )                                                            | 25   |         | 25    |     | 25         |     | 25  |     |  |
| 11a    | tASC            | Column Address Setup Time (tASC = 0)                                                            | 0    |         | 0     |     | 0          |     | 0   |     |  |
| 11b    | tASC            | Column Address Setup Time (tASC = 10)                                                           | 10   |         | 10    |     | 10         |     | 10  |     |  |
| 12     | <b>tPCKRAS</b>  | CLK High to RAS Asserted following Precharge                                                    |      | 16      |       | 20  |            | 16  |     | 20  |  |
| 13     | <b>tPARQRAS</b> | AREQ Negated to RAS Negated                                                                     |      | 21      |       | 25  |            | 21  |     | 25  |  |
| 14     | tPENCL          | ECAS0-3 Asserted to CAS Asserted                                                                |      | 15      |       | 22  |            | 15  |     | 22  |  |
| 15     | <b>tPENCH</b>   | ECAS0-3 Negated to CAS Negated                                                                  |      | 16      |       | 23  |            | 16  |     | 23  |  |
| 16     | <b>tPARQCAS</b> | AREQ Negated to CAS Negated                                                                     |      | 37      |       | 44  |            | 37  |     | 44  |  |
| 17     | tPCLKWH         | CLK to WAIT Negated                                                                             |      | 23      |       | 23  |            | 23  |     | 23  |  |
| 18     | tPCLKDL0        | CLK to DTACK Asserted<br>(Programmed as DTACK of 1/2, 1, 1½<br>or if WAITIN is Asserted)        |      | 23      |       | 23  |            | 23  |     | 23  |  |
| 19     | tPEWL           | ECAS Negated to WAIT Asserted<br>during a Burst Access                                          |      | 28      |       | 28  |            | 28  |     | 28  |  |
| 20     | tSECK           | ECAS Asserted Setup to CLK High to<br>Recognize the Rising Edge of CLK<br>during a Burst Access | 13   |         | 13    |     | 13         |     | 13  |     |  |

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C  $< T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or

- $C_H=50~\text{pF}$  loads on all outputs except  $C_H=125~\text{pF}$  loads on RAS0–3 and CAS0–3 and  $C_H=380~\text{pF}$  loads on Q0–8, 9, 10 and WE.

|        |          |                                                                                                                        | DP8 | 420V/21 | V/22V | -33 |     | DP84T2 | 2-25 |     |
|--------|----------|------------------------------------------------------------------------------------------------------------------------|-----|---------|-------|-----|-----|--------|------|-----|
| Number | Symbol   | Common Parameter<br>Description                                                                                        | С   | L       | C     | 'n  | С   | L      | C    | н   |
|        |          | Description                                                                                                            | Min | Max     | Min   | Max | Min | Max    | Min  | Max |
| 21     | tPEDL    | ECAS Asserted to DTACK<br>Asserted during a Burst Access<br>(Programmed as DTACK0)                                     |     | 28      |       | 28  |     | 28     |      | 28  |
| 22     | tPEDH    | ECAS Negated to DTACK<br>Negated during a Burst Access                                                                 |     | 30      |       | 30  |     | 30     |      | 30  |
| 23     | tSWCK    | WAITIN Asserted Setup to CLK                                                                                           | 4   |         | 4     |     | 4   |        | 4    |     |
| 24     | tPWINWEH | WIN Asserted to WE Asserted                                                                                            |     | 23      |       | 33  |     | 23     |      | 33  |
| 25     | tPWINWEL | $\overline{\text{WIN}}$ Negated to $\overline{\text{WE}}$ Negated                                                      |     | 23      |       | 33  |     | 23     |      | 33  |
| 26     | tPAQ     | Row, Column Address Valid to Q0-8, 9, 10 Valid                                                                         |     | 21      |       | 30  |     | 21     |      | 30  |
| 27     | tPCINCQ  | COLINC Asserted to Q0-8, 9, 10<br>Incremented                                                                          |     | 24      |       | 33  |     | 24     |      | 33  |
| 28     | tSCINEN  | COLINC Asserted Setup to $\overline{\text{ECAS}}$<br>Asserted to Ensure tASC = 0 ns                                    | 13  |         | 15    |     | 13  |        | 15   |     |
| 29a    | tSARQCK1 | AREQ, AREQB Negated Setup to CLK<br>High with 1 Period of Precharge                                                    | 29  |         | 29    |     | 29  |        | 29   |     |
| 29b    | tSARQCK2 | $\overline{\text{AREQ}}$ , $\overline{\text{AREQB}}$ Negated Setup to CLK High with > 1 Period of Precharge Programmed | 10  |         | 10    |     | 10  |        | 10   |     |
| 30     | tPAREQDH | AREQ Negated to DTACK Negated                                                                                          |     | 20      |       | 20  |     | 20     |      | 20  |
| 31     | tPCKCAS  | CLK High to CAS Asserted<br>when Delayed by WIN                                                                        |     | 15      |       | 22  |     | 15     |      | 22  |
| 32     | tSCADEN  | Column Address Setup to $\overline{\text{ECAS}}$<br>Asserted to Guarantee tASC = 0                                     | 7   |         | 8     |     | 7   |        | 8    |     |
| 33     | tWCINC   | COLINC Pulse Width                                                                                                     | 10  |         | 10    |     | 10  |        | 10   |     |
| 34a    | tPCKCL0  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 15 ns, tASC = 0 ns)                               |     | 65      |       | 75  |     | 65     |      | 75  |
| 34b    | tPCKCL1  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 15 ns, tASC = 10 ns)                              |     | 75      |       | 83  |     | 75     |      | 83  |
| 34c    | tPCKCL2  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 0 ns)                               |     | 75      |       | 83  |     | 75     |      | 83  |
| 34d    | tPCKCL3  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 10 ns)                              |     | 85      |       | 93  |     | 85     |      | 93  |
| 35     | tCAH     | Column Address Hold Time<br>(Interleave Mode Only)                                                                     | 25  |         | 25    |     | 25  |        | 25   |     |
| 36     | tPCQR    | CAS Asserted to Row Address<br>Valid (Interleave Mode Only)                                                            |     | 70      |       | 70  |     | 70     |      | 70  |

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C  $< T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

- Two different loads are specified:
- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and WE; or

to High Level Delay from TRI-STATE

to TRI-STATE

to TRI-STATE

Delay from TRI-STATE

82

83

t<sub>PLZ</sub>

t<sub>PHZ</sub>

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0-3 and CAS0-3 and  $C_H=380$  pF loads on Q0-8, 9, 10 and WE.

50

45

50

45

|        |                  |                                                                                   | DP8 | 420V/21  | V/22V- | 33         | DP84T22-25 |        |     |              |  |
|--------|------------------|-----------------------------------------------------------------------------------|-----|----------|--------|------------|------------|--------|-----|--------------|--|
| Number | Symbol           | Difference<br>Parameter Description                                               | С   | L        | C      | Эн         | CL         |        | C   | н            |  |
|        |                  |                                                                                   | Min | Max      | Min    | Max        | Min        | Max    | Min | Max          |  |
| 50     | tD1              | (AREQ or AREQB Negated to RAS<br>Negated) Minus (CLK High to RAS<br>Asserted)     |     | 9        |        | 9          |            | 9      |     | 9            |  |
| 51     | tD2              | (CLK High to Refresh RAS Negated)<br>Minus (CLK High to RAS Asserted)             |     | 7        |        | 7          |            | 7      |     | 7            |  |
| 52     | tD3a             | (ADS Asserted to RAS Asserted<br>(Mode 1)) Minus (AREQ Negated<br>to RAS Negated) |     | 2        |        | 2          |            | 2      |     | 2            |  |
| 53     | tD3b             | (CLK High to RAS Asserted (Mode 0))<br>Minus (AREQ Negated to RAS Negated)        |     | 2        |        | 2          |            | 2      |     | 2            |  |
| 54     | tD4              | (ECAS Asserted to CAS Asserted)<br>Minus (ECAS Negated to CAS Negated)            | -4  | 4        | -4     | 4          | -4         | 4      | -4  | 4            |  |
| 55     | tD5              | (CLK to Refresh RAS Asserted) Minus<br>(CLK to Refresh RAS Negated)               |     | 2        |        | 2          |            | 2      |     | 2            |  |
| 52     | tD2              | (AREQ Negated to RAS Negated)<br>Minus (ADS Asserted to RAS<br>Asserted (Mode 1)) |     | 4        |        | 4          |            | 4      |     | 4            |  |
|        |                  |                                                                                   |     |          |        |            |            |        |     |              |  |
|        |                  | TRI-STATE                                                                         |     | 8420V/21 | 1      |            |            | DP84T2 | r   |              |  |
| Number | Symbol           | Parameter Description                                                             | C   | T        |        | 2 <u>H</u> | C          | T      |     | Эн<br>IIIIII |  |
|        |                  |                                                                                   | Min | Max      | Min    | Max        | Min        | Max    | Min | Max          |  |
| 80     | t <sub>PZL</sub> | Delay from TRI-STATE<br>to Low Level                                              |     |          |        |            |            | 20     |     | 20           |  |
| 81     | t <sub>PZH</sub> | Delay from TRI-STATE                                                              |     |          |        |            |            | 30     |     | 30           |  |

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

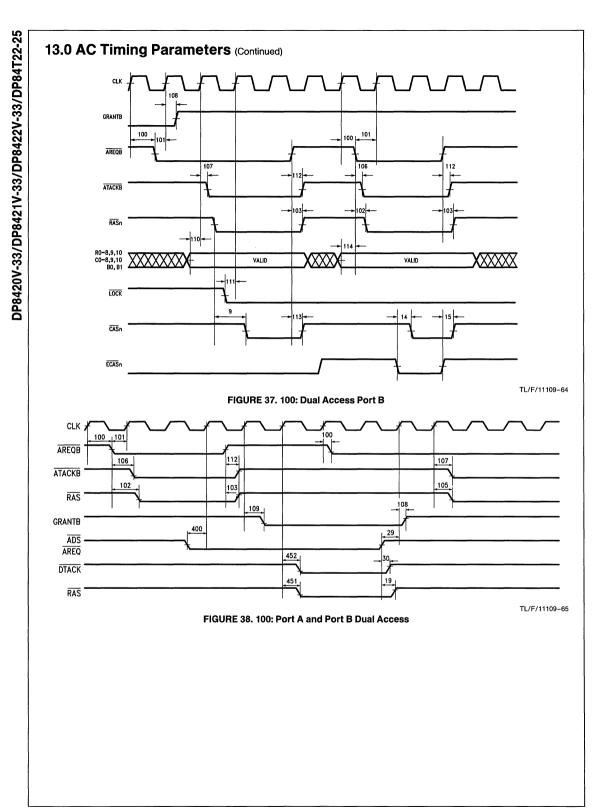
Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or

 $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0–3 and CAS0–3 and  $C_H=380$  pF loads on Q0–8, 9, 10 and WE.

| 101       t         102       t         103       t         105       t         106       t         107       t         108       t         109       t         101       t         102       t         103       t         106       t         107       t         110       t         111       t         112       t         113       t         114       t         118       t         118a       t         118b       t         120a       t         120b       t         120c       t |                   | Common Dual Access                                                                                              | DP8 | 420V/21 | V/22V | -33 |     | DP84T2 | 2-25 |     |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------|-----------------------------------------------------------------------------------------------------------------|-----|---------|-------|-----|-----|--------|------|-----|
| Number                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Symbol            | Parameter Description                                                                                           | С   | L       | C     | н   | С   | L      | C    | н   |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |                   |                                                                                                                 | Min | Max     | Min   | Max | Min | Max    | Min  | Max |
| 100                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tHCKARQB          | AREQB Negated Held from CLK High                                                                                | 2   |         | 2     |     | 2   |        | 2    |     |
| 101                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tSARQBCK          | AREQB Asserted Setup to CLK High                                                                                | 4   |         | 4     |     | 4   |        | 4    |     |
| 102                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tPAQBRASL         | AREQB Asserted to RAS Asserted                                                                                  |     | 28      |       | 32  |     | 28     |      | 32  |
| 103                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tPAQBRASH         | AREQB Negated to RAS Negated                                                                                    | l   | 25      |       | 30  |     | 25     |      | 30  |
| 105                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tPCKRASG          | CLK High to RAS Asserted for<br>Pending Port B Access                                                           |     | 35      |       | 40  |     | 35     |      | 40  |
| 106                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | <b>tPAQBATKBL</b> | AREQB Asserted to ATACKB Asserted                                                                               |     | 33      |       | 33  |     | 33     |      | 33  |
| 107                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | <b>tPCKATKB</b>   | CLK High to ATACKB Asserted<br>for Pending Access                                                               |     | 40      |       | 40  |     | 40     |      | 40  |
| 108                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tPCKGH            | CLK High to GRANTB Asserted                                                                                     |     | 26      |       | 26  |     | 26     |      | 26  |
| 109                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tPCKGL            | CLK High to GRANTB Negated                                                                                      |     | 20      |       | 20  |     | 20     |      | 20  |
| 110                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tSADDCKG          | Row Address Setup to CLK High That<br>Asserts RAS following a GRANTB<br>Change to Ensure tASR = 0 ns for Port B | 7   |         | 11    |     | 7   |        | 11   |     |
| 111                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tSLOCKCK          | LOCK Asserted Setup to CLK Low to Lock Current Port                                                             | 2   |         | 2     |     | 2   |        | 2    |     |
| 112                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | <b>tPAQATKBH</b>  | AREQ Negated to ATACKB Negated                                                                                  |     | 10      |       | 10  |     | 10     |      | 10  |
| 113                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | <b>tPAQBCASH</b>  | AREQB Negated to CAS Negated                                                                                    |     | 35      |       | 42  |     | 35     |      | 42  |
| 114                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tSADAQB           | Address Valid Setup to<br>AREQB Asserted                                                                        | 3   |         | 7     |     | 3   |        | 7    |     |
| 116                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tHCKARQG          | AREQ Negated Held from CLK High                                                                                 | 3   |         | 3     |     | 3   |        | 3    |     |
| 117                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tWAQB             | $\overline{\text{AREQB}}$ High Pulse Width to Guarantee tASR = 0 ns                                             | 15  |         | 17    |     | 15  |        | 17   |     |
| 118a                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPAQBCAS0         | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)           |     | 80      |       | 87  |     | 80     |      | 87  |
| 118b                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPAQBCAS1         | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)          |     | 90      |       | 97  |     | 90     |      | 97  |
| 118c                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPAQBCAS2         | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)           |     | 90      |       | 97  |     | 90     |      | 97  |
| 118d                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPAQBCAS3         | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)          |     | 100     |       | 107 |     | 100    |      | 107 |
| 120a                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPCKCASG0         | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 15 ns, tASC = 0 ns)               |     | 80      |       | 87  |     | 80     |      | 87  |
| 120b                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPCKCASG1         | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 15 ns, tASC = 10 ns)              |     | 90      |       | 97  |     | 90     |      | 97  |
| 120c                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPCKCASG2         | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 25 ns, tASC = 0 ns)               |     | 90      |       | 97  |     | 90     |      | 97  |
| 120d                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | tPCKCASG3         | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 25 ns, tASC = 10 ns)              |     | 100     |       | 107 |     | 100    |      | 107 |
| 121                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | tSBADDCKG         | Bank Address Valid Setup to CLK<br>High That Starts RAS<br>for Pending Port B Access                            | 5   |         | 5     |     | 5   |        | 5    |     |



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## 13.0 AC Timing Parameters (Continued)

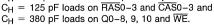
Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C  $< T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

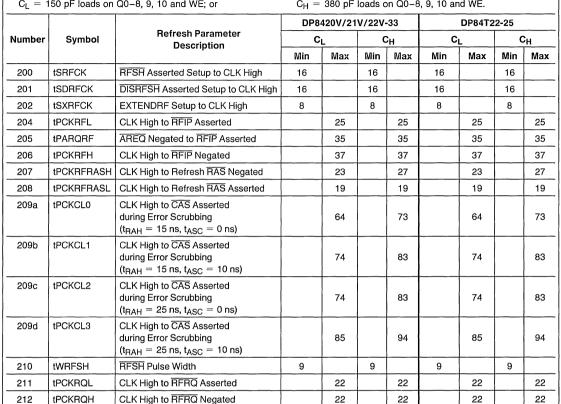
Two different loads are specified:

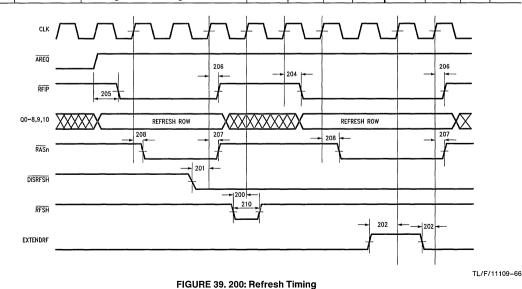
 $C_1 = 50 \text{ pF}$  loads on all outputs except

 $C_{L}^{-}$  = 150 pF loads on Q0-8, 9, 10 and WE; or

 $C_H = 50 \text{ pF}$  loads on all outputs except







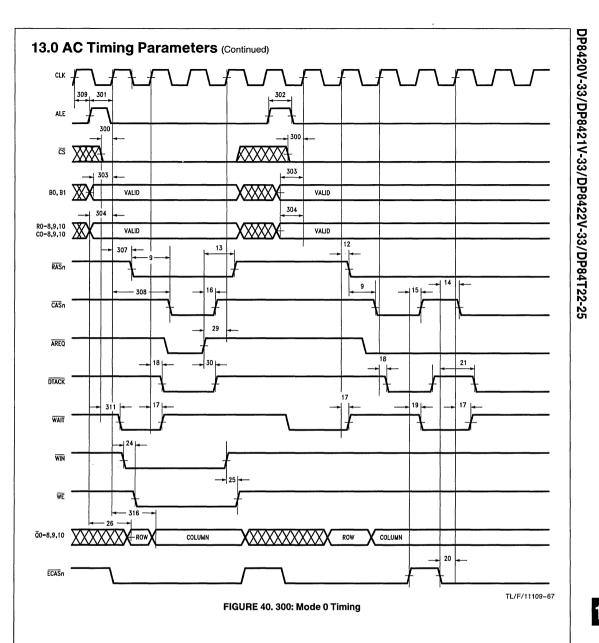
Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

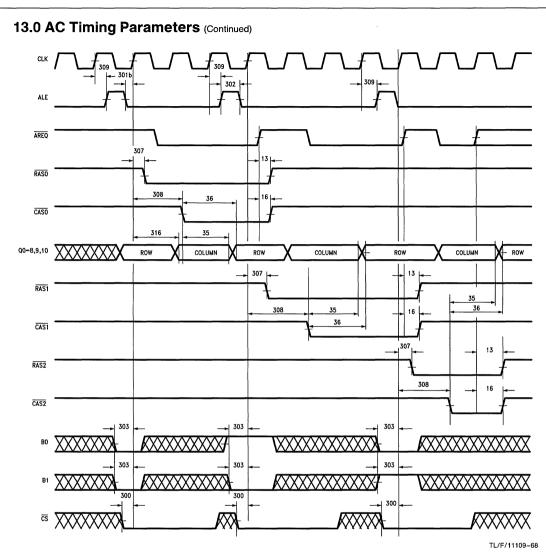
Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{\text{WE}}$ ; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380$  pF loads on Q0-8, 9, 10 and  $\overline{WE}.$

|        |           |                                                                                                                                     | DP8 | 420V/21 | V/22V- | -33 |     | DP84T2 | 2-25 |     |
|--------|-----------|-------------------------------------------------------------------------------------------------------------------------------------|-----|---------|--------|-----|-----|--------|------|-----|
| Number | Symbol    | Mode 0 Access<br>Parameter Description                                                                                              | С   | L       | C      | йн  | С   |        | C    | н   |
|        |           | Parameter Description                                                                                                               | Min | Max     | Min    | Max | Min | Max    | Min  | Max |
| 300    | tSCSCK    | CS Asserted to CLK High                                                                                                             | 8   |         | 8      |     | 8   |        | 8    |     |
| 301a   | tSALECKNL | ALE Asserted Setup to CLK High<br>Not Using On-Chip Latches or<br>if Using On-Chip Latches and<br>B0, B1, Are Constant, Only 1 Bank | 10  |         | 10     |     | 10  |        | 10   |     |
| 301b   | tSALECKL  | ALE Asserted Setup to CLK High,<br>if Using On-Chip Latches if B0, B1<br>Can Change, More Than One Bank                             | 18  |         | 18     |     | 18  |        | 18   |     |
| 302    | tWALE     | ALE Pulse Width                                                                                                                     | 15  |         | 15     |     | 15  |        | 15   |     |
| 303    | tSBADDCK  | Bank Address Valid Setup to CLK High                                                                                                | 10  |         | 10     |     | 10  |        | 10   |     |
| 304    | tSADDCK   | Row, Column Valid Setup to<br>CLK High to Guarantee<br>tASR = 0 ns                                                                  | 4   |         | 8      |     | 4   |        | 8    |     |
| 305    | tHASRCB   | Row, Column, Bank Address<br>Held from ALE Negated<br>(Using On-Chip Latches)                                                       | 6   |         | 6      |     | 6   |        | 6    |     |
| 306    | tSRCBAS   | Row, Column, Bank Address<br>Setup to ALE Negated<br>(Using On-Chip Latches)                                                        | 1   |         | 1      |     | 1   |        | 1    |     |
| 307    | tPCKRL    | CLK High to RAS Asserted                                                                                                            |     | 20      |        | 25  |     | 20     |      | 25  |
| 308a   | tPCKCL0   | CLK High to $\overline{CAS}$ Asserted<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)                                        |     | 63      |        | 70  |     | 63     |      | 70  |
| 308b   | tPCKCL1   | CLK High to $\overline{CAS}$ Asserted<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 10 ns)                                       |     | 74      |        | 81  |     | 74     |      | 81  |
| 308c   | tPCKCL2   | CLK High to $\overline{CAS}$ Asserted<br>( $t_{RAH} = 25 \text{ ns}, t_{ASC} = 0 \text{ ns}$ )                                      |     | 74      |        | 81  |     | 74     |      | 81  |
| 308d   | tPCKCL3   | CLK High to $\overline{CAS}$ Asserted<br>( $t_{RAH} = 25$ ns, $t_{ASC} = 10$ ns)                                                    |     | 88      |        | 95  |     | 88     |      | 95  |
| 309    | tHCKALE   | ALE Negated Hold from CLK High                                                                                                      | 0   |         | 0      |     | 0   |        | 0    |     |
| 310    | tSWINCK   | WIN Asserted Setup to CLK High to Guarantee CAS is Delayed                                                                          | -21 |         | -21    |     | -16 |        | -16  |     |
| 311    | tPCSWL    | CS Asserted to WAIT Asserted                                                                                                        |     | 16      |        | 16  |     | 16     |      | 16  |
| 312    | tPCSWH    | CS Negated to WAIT Negated                                                                                                          |     | 18      |        | 18  |     | 18     |      | 18  |
| 313    | tPCLKDL1  | CLK High to DTACK Asserted<br>(Programmed as DTACK0)                                                                                |     | 25      |        | 25  |     | 25     |      | 25  |
| 314    | tPALEWL   | ALE Asserted to $\overline{\text{WAIT}}$ Asserted<br>( $\overline{\text{CS}}$ is Already Asserted)                                  |     | 20      |        | 20  |     | 20     |      | 20  |
| 315    |           | $\begin{tabular}{lllllllllllllllllllllllllllllllllll$                                                                               | 25  |         | 29     |     | 25  |        | 29   |     |
| 316    | tPCKCV0   | CLK High to Column<br>Address Valid<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)                                          |     | 55      |        | 60  |     | 55     |      | 60  |
| 317    | tPCKCV1   | CLK High to Column<br>Address Valid<br>(t <sub>RAH</sub> = 25 ns, t <sub>ASC</sub> = 0 ns)                                          |     | 65      |        | 65  |     | 65     |      | 65  |





(Programmed as C4 = 1, C5 = 1, C6 = 1)

DP8420V-33/DP8421V-33/DP8422V-33/DP84T22-25



Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

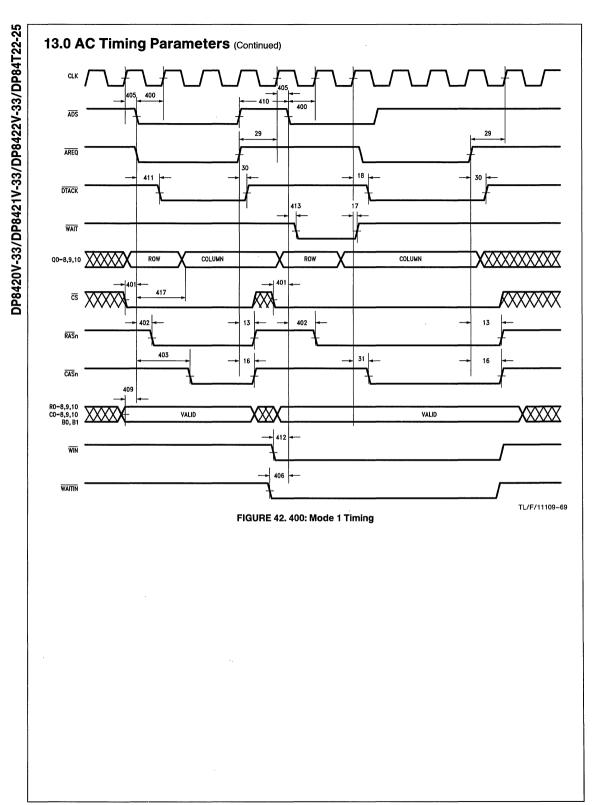
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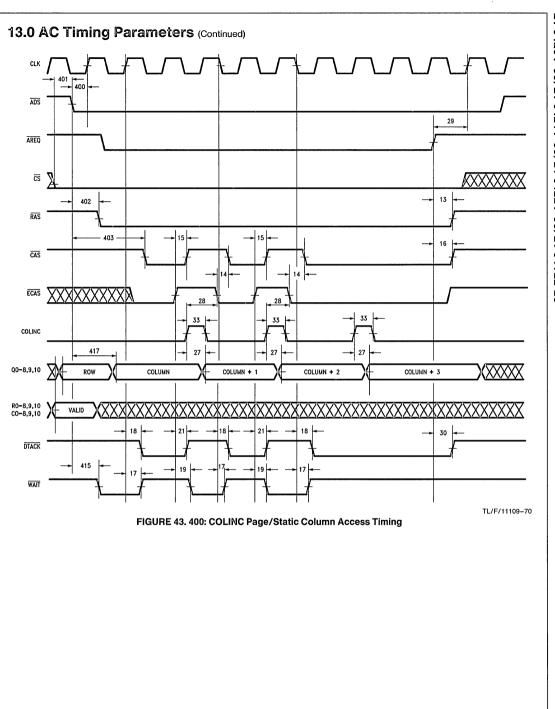
 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_{L} = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or

- $C_H = 50 \text{ pF}$  loads on all outputs except
- $C_{H} = 125 \text{ pF}$  loads on RAS0-3 and CAS0-3 and  $C_{H} = 380 \text{ pF}$  loads on Q0-8, 9, 10 and WE.

|        |          |                                                                                                                                 | DP  | 8420V/2 | 21V/22V | -33 | DP84T22-25 |     |     |     |
|--------|----------|---------------------------------------------------------------------------------------------------------------------------------|-----|---------|---------|-----|------------|-----|-----|-----|
| Number | Symbol   | Mode 1 Access Parameter Description                                                                                             | c   | L.      | c       | н   | С          | L   | С   | н   |
|        |          |                                                                                                                                 | Min | Max     | Min     | Max | Min        | Max | Min | Max |
| 400a   | tSADSCK1 | ADS Asserted Setup to CLK High                                                                                                  | 8   |         | 8       |     | 8          |     | 8   |     |
| 400b   | tSADSCKW | ADS Asserted Setup to CLK<br>(to Guarantee Correct WAIT<br>or DTACK Output; Doesn't Apply for DTACK0)                           | 19  |         | 19      |     | 19         |     | 19  |     |
| 401    | tSCSADS  | CS Setup to ADS Asserted                                                                                                        | 2   |         | 2       |     | 2          |     | 2   |     |
| 402    | tPADSRL  | ADS Asserted to RAS Asserted                                                                                                    |     | 21      |         | 25  |            | 21  |     | 25  |
| 403a   | tPADSCL0 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)                             |     | 68      |         | 75  |            | 68  |     | 75  |
| 403b   | tPADSCL1 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)                            |     | 78      |         | 85  |            | 78  |     | 85  |
| 403c   | tPADSCL2 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)                             |     | 78      |         | 85  |            | 78  |     | 85  |
| 403d   | tPADSCL3 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)                            |     | 88      |         | 95  |            | 88  |     | 95  |
| 404    | tSADDADS | Row Address Valid Setup to $\overline{ADS}$<br>Asserted to Guarantee tASR = 0 ns                                                | 3   |         | 5       |     | 3          |     | 5   |     |
| 405    | tHCKADS  | ADS Negated Held from CLK High                                                                                                  | 0   |         | 0       |     | 0,         |     | 0   |     |
| 406    | tSWADS   | WAITIN Asserted Setup to ADS<br>Asserted to Guarantee DTACK0<br>Is Delayed                                                      | 0   |         | 0       |     | 0          |     | 0   |     |
| 407    | tSBADAS  | Bank Address Setup to ADS Asserted                                                                                              | 6   |         | 6       |     | 6          |     | 6   |     |
| 408    | tHASRCB  | Row, Column, Bank Address Held from ADS Asserted (Using On-Chip Latches)                                                        | 6   |         | 6       |     | 6          |     | 6   |     |
| 409    | tSRCBAS  | Row, Column, Bank Address Setup to<br>ADS Asserted (Using On-Chip Latches)                                                      | 1   |         | 1       |     | 1          |     | 1   |     |
| 410    | tWADSH   | ADS Negated Pulse Width                                                                                                         | 12  |         | 16      |     | 12         |     | 17  |     |
| 411    | tPADSD   | ADS Asserted to DTACK Asserted<br>(Programmed as DTACK0)                                                                        |     | 28      |         | 28  |            | 28  |     | 28  |
| 412    | tSWINADS | WIN Asserted Setup to ADS Asserted<br>(to Guarantee CAS Delayed during<br>Writes Accesses)                                      | -10 |         | -10     |     | -10        |     | -10 |     |
| 413    | tPADSWL0 | ADS Asserted to WAIT Asserted<br>(Programmed as WAIT0, Delayed Access)                                                          |     | 20      |         | 20  |            | 20  |     | 20  |
| 414    | tPADSWL1 | ADS Asserted to WAIT Asserted<br>(Programmed WAIT 1/2 or 1)                                                                     |     | 20      |         | 20  |            | 20  |     | 20  |
| 415    | tPCLKDL1 | CLK High to DTACK Asserted<br>(Programmed as DTACK0,<br>Delayed Access)                                                         |     | 25      |         | 25  |            | 25  |     | 25  |
| 416    |          | $\overline{\text{AREQ}}$ Negated to $\overline{\text{ADS}}$ Asserted<br>to Guarantee tASR = 0 ns<br>(Non Interleaved Mode Only) | 18  |         | 20      |     | 18         |     | 20  |     |
| 417    | tPADSCV0 | $\overline{\text{ADS}}$ Asserted to Column<br>Address Valid<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)              |     | 51      |         | 60  |            | 51  |     | 60  |





DP8420V-33/DP8421V-33/DP8422V-33/DP84T22-25

**[**]

tSBADDCKG

tSADSCK0

Bank Address Valid Setup to CLK High

that Asserts **RAS** for Pending Access

ADS Asserted Setup to CLK High

454

455

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified: C<sub>H</sub> = 50 pF loads on all outputs except  $C_{H} = 125 \text{ pF}$  loads on  $\overline{RAS0}-3$  and  $\overline{CAS0}-3$  and  $C_L = 50 \text{ pF}$  loads on all outputs except  $C_H = 380 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ .  $C_{L} = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or DP8420V/21V/22V-33 DP84T22-25 Mode 1 Dual Access Number Symbol С С Сн Сн **Parameter Description** Min Max Min Max Min Max Min Max 450 **tSADDCKG** Row Address Setup to CLK High That Asserts RAS following a GRANTB 7 7 11 11 Port Change to Ensure tASR = 0 ns CLK High to RAS Asserted 451 **tPCKRASG** 30 35 30 35 for Pending Access CLK to DTACK Asserted for Delayed tPCLKDL2 452 33 33 33 33 Accesses (Programmed as DTACK0) 453a tPCKCASG0 CLK High to CAS Asserted for Pending Access 81 89 81 89  $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns})$ 453b CLK High to CAS Asserted tPCKCASG1 91 91 99 for Pending Access 99  $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 10 \text{ ns})$ 453c tPCKCASG2 CLK High to CAS Asserted for Pending Access 91 99 91 99  $(t_{RAH} = 25 \text{ ns}, t_{ASC} = 0 \text{ ns})$ 453d tPCKCASG3 CLK High to CAS Asserted for Pending Access 101 109 101 109  $(t_{RAH} = 25 \text{ ns}, t_{ASC} = 10 \text{ ns})$ 

з

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Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C  $< T_A < 70°C$ , the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or

- $C_H = 50 \text{ pF}$  loads on all outputs except
- $C_{H} = 125 \text{ pF}$  loads on RAS0-3 and CAS0-3 and  $C_{H} = 380 \text{ pF}$  loads on Q0-8, 9, 10 and WE.

| Number |          |                                                    |     | DP8420V/21V/22V-33 |                |     |     |     | DP84T22-25 |     |  |  |
|--------|----------|----------------------------------------------------|-----|--------------------|----------------|-----|-----|-----|------------|-----|--|--|
|        | Symbol   | mbol Programming Programming Parameter Description | CL  |                    | С <sub>Н</sub> |     | CL  |     | С          | н   |  |  |
|        |          | Falameter Description                              | Min | Max                | Min            | Max | Min | Max | Min        | Max |  |  |
| 500    | tHMLADD  | Mode Address Held from ML Negated                  | 4   |                    | 4              |     | 4   |     | 4          |     |  |  |
| 501    | tSADDML  | Mode Address Setup to ML Negated                   | 3   |                    | 3              |     | 3   |     | 3          |     |  |  |
| 502    | tWML     | ML Pulse Width                                     | 9   |                    | 9              |     | 9   |     | 9          |     |  |  |
| 503    | tSADAQML | Mode Address Setup to AREQ Asserted                | 0   |                    | 0              |     | 0   |     | 0          |     |  |  |
| 504    | tHADAQML | Mode Address Held from AREQ Asserted               | 30  |                    | 30             |     | 30  |     | 30         |     |  |  |
| 505    | tSCSARQ  | CS Asserted Setup to<br>AREQ Asserted              | 3   |                    | 3              |     | 3   |     | 3          |     |  |  |
| 506    | tSMLARQ  | ML Asserted Setup to AREQ Asserted                 | 6   |                    | 6              |     | 6   |     | 6          |     |  |  |

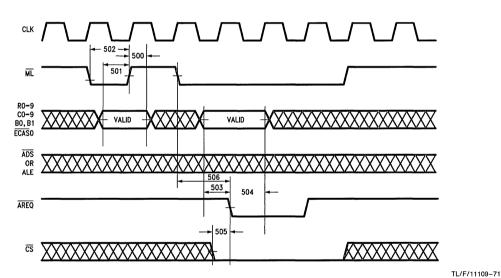


FIGURE 44. 500: Programming

## 14.0 Functional Differences between the DP8420V/21V/22V, DP84T22 and the DP8420/21/22

#### 1. Extending the Column Address Strobe (CAS) after AREQ Transitions High

The DP8420V/21V/22V, DP84T22 allows  $\overline{CAS}$  to be asserted for an indefinite period of time beyond  $\overline{AREQ}$  (or  $\overline{AREQB}$ , DP8422V, DP84T22 only. Scrubbing refreshes are not affected.) being negated by continuing to assert the appropriate  $\overline{ECAS}$  inputs. This feature is allowed as long as the  $\overline{ECAS}$  input was negated during programming. The DP8420/21/22 does not allow this feature.

#### 2. Dual Accessing

The DP8420V/21V/22V, DP84T22 asserts RAS either one or two clock periods after GRANTB has been asserted or negated depending upon how the R0 bit was programmed during the mode load operation. The DP8420/21/22 will always start RAS one clock period after GRANTB is asserted or negated. The above statements assume that RAS precharge has been completed by the time GRANTB is asserted or negated.

#### 3. Refresh Request Output (RFRQ)

The DP8420V/21V/22V, DP84T22 allows  $\overline{\text{RFRQ}}$  (refresh request) to be output on the  $\overline{\text{WE}}$  output pin given that  $\overline{\text{ECAS0}}$  was negated during programming or the controller was programmed to function in the address pipelining (memory interleaving) mode. The DP8420/21/22 only allows  $\overline{\text{RFRQ}}$  to be output during the address pipelining mode.

#### 4. Clearing the Refresh Request Clock Counter

The DP8420V/21V/22V, DP84T22 allows the internal refresh request clock counter to be cleared by negating DISRFSH and asserting RFSH for at least 500 ns. The DP8420/211/22 clears the internal refresh request clock counter if DISRFSH remains low for at least 500 ns. Once the internal refresh request clock counter is cleared the user is guaranteed that an internally generated RFRQ will not be generated for at least 13  $\mu$ s-15  $\mu$ s (depending upon how programming bits C0, 1, 2, 3 were programmed).

## 15.0 DP8420V/21V/22V, DP84T22 User Hints

- 1. All inputs to the DP8420V/21V/22V, DP84T22 should be tied high, low or the output of some other device. Note: One signal is active high. COLINC (EXTNDRF) should be tied low to disable.
- 2. Each ground on the DP8420V/21V/22V, DP84T22 must be decoupled to the closest on-chip supply (V<sub>CC</sub>) with 0.1  $\mu$ F ceramic capacitor. This is necessary because these grounds are kept separate inside the DP8420V/21V/22V, DP84T22. The decoupling capacitors should be placed as close as possible with short leads to the ground and supply pins of the DP8420V/21V/22V, DP84T22.
- 3. The output called "CAP" should have a 0.1  $\mu\text{F}$  capacitor to ground.
- 4. The DP8420V/21V/22V, DP84T22 has 20Ω series damping resistors built into the output drivers of RAS, CAS, address and WE/RFRQ. Space should be provided

for external damping resistors on the printed circuit board (or wire-wrap board) because they may be needed. The value of these damping resistors (if needed) will vary depending upon the output, the capacitance of the load, and the characteristics of the trace as well as the routing of the trace. The value of the damping resistor also may vary between the wire-wrap board and the printed circuit board. To determine the value of the series damping resistor it is recommended to use an oscilloscope and look at the furthest DRAM from the DP8420V/21V/22V. DP84T22. The undershoot of RAS, CAS, WE and the addresses should be kept to less than 0.5V below ground by varying the value of the damping resistor. The damping resistors should be placed as close as possible with short leads to the driver outputs of the DP8420V/21V/ 22V. DP84T22.

- 5. The circuit board must have a good V<sub>CC</sub> and ground plane connection. If the board is wire-wrapped, the V<sub>CC</sub> and ground pins of the DP8420V/21V/22V, DP84T22, the DRAM associated logic and buffer circuitry must be soldered to the V<sub>CC</sub> and ground planes.
- 6. The traces from the DP8420V/21V/22V, DP84T22 to the DRAM should be as short as possible.
- ECAS0 should be held low during programming if the user wishes that the DP8420V/21V/22V, DP84T22 be compatible with a DP8420/21/22 design.
- 8. Parameter Changes due to Loading

All A.C. parameters are specified with the equivalent load capacitances, including traces, of 64 DRAMs organized as 4 banks of 18 DRAMs each. Maximums are based on worst-case conditions. If an output load changes then the A.C. timing parameters associated with that particular output must be changed. For example, if we changed our output load to

- C = 250 pF loads on  $\overline{RAS0}-3$  and  $\overline{CAS0}-3$
- C= 760 pF loads on Q0–9 and  $\overline{WE}$
- we would have to modify some parameters (not all calculated here)
- \$308a clock to CAS asserted
- $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns})$

A ratio can be used to figure out the timing change per change in capacitance for a particular parameter by using the specifications and capacitances from heavy and light load timing.

Ratio = 
$$\frac{\$308a \text{ w/Heavy Load} - \$308a \text{ w/Light Load}}{C_{H}(\overline{CAS}) - C_{L}(\overline{CAS})}$$
$$= \frac{79 \text{ ns} - 72 \text{ ns}}{125 \text{ pF} - 50 \text{ pF}} = \frac{7 \text{ ns}}{75 \text{ pF}}$$

= 
$$(250 \text{ pF} - 125 \text{ pF}) \frac{7 \text{ ns}}{75 \text{ pF}} + 79 \text{ ns}$$
  
=  $11.7 \text{ ns} + 79 \text{ ns}$   
=  $90.7 \text{ ns} @ 250 \text{ pF}$  load

9. It is required that the user perform a hardware reset to the DP8420V/21V/22V, DP84T22 before programming and using the chip. A hardware reset consists of asserting both ML and DISRFSH for a minimum of 16 positive edges of CLK, see Section 3.1.



## PRELIMINARY

# DP8430V/31V/32V-33 microCMOS Programmable 256k/1M/4M Dynamic RAM Controller/Drivers

## **General Description**

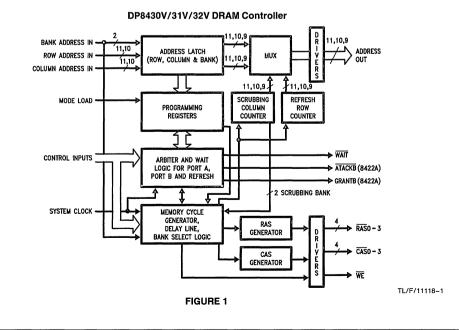
The DP8430V/31V/32V dynamic RAM controllers provide a low cost, single chip interface between dynamic RAM and all 8-, 16- and 32-bit systems. The DP8430V/31V/32V generate all the required access control signal timing for DRAMs. An on-chip refresh request clock is used to automatically refresh the DRAM array. Refreshes and accesses are arbitrated on chip. If necessary, a WAIT or DTACK output inserts wait states into system access cycles, including burst mode accesses. RAS low time during refreshes and RAS precharge time after refreshes and back to back accesses are guaranteed through the insertion of wait states. Separate on-chip precharge counters for each RAS output can be used for memory interleaving to avoid delayed back to back accesses because of precharge. An additional feature of the DP8432V is two access ports to simplify dual accessing. Arbitration among these ports and refresh is done on chip.

## Features

- On chip high precision delay line to guarantee critical DRAM access timing parameters
- microCMOS process for low power
- High capacitance drivers for RAS, CAS, WE and DRAM address on chip
- On chip support for nibble, page and static column DRAMs
- Byte enable signals on chip allow byte writing in a word size up to 32 bits with no external logic
- Can use a single clock source. Up to 33 MHz operating frequency
- On board Port A/Port B (DP8432V only)/refresh arbitration logic
- Direct interface to all major microprocessors
- □ 4 RAS and 4 CAS drivers (the RAS and CAS configuration is programmable)

| Control    | # of Pins<br>(PLCC) | # of Address<br>Outputs | Largest<br>DRAM<br>Possible | Direct Drive<br>Memory<br>Capacity | Access<br>Ports<br>Available |  |
|------------|---------------------|-------------------------|-----------------------------|------------------------------------|------------------------------|--|
| DP8430V 68 |                     | 9                       | 256 kbit                    | 4 Mbytes                           | Single Access Port           |  |
| DP8431V 68 |                     | 10                      | 1 Mbit                      | 16 Mbytes                          | Single Access Port           |  |
| DP8432V    | 84                  | 11                      | 4 Mbit                      | 64 Mbytes                          | Dual Access Ports (A and B)  |  |

## **Block Diagram**



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## **1.0 Introduction**

The DP8430V/31V/32V DRAM controllers are the latest devices based upon the DP8420A/21A/22A predecessors. The DP8430V/31V/32V implement changes which do not allow them to be pin compatible with any of the DP842XA or the DP842XV DRAM controllers. Two changes have been made: The limits for the input frequency to DELCLK have been increased making possible the use of a single clock source. A RESET input is now available making the reset procedure easier. These changes, although minimal, facilitate the use of the controllers and make them even more attractive for high performance applications. The controllers incorporate address latches, refresh counter, row/column/ refresh address multiplexer, delay line, refresh/access/precharge arbitration logic and high capacitive drivers. The DP8430V/31V/32V DRAM controllers allow any manufacturer's CPU or bus to directly interface to DRAM arrays up to 64 Mbytes in size.

#### Reset:

The user must reset the controller before programming it. Reset is achieved by asserting the RESET input for at least 16 positive edges of clock.

#### Programming:

After reset, the user can program the controller by either one of two methods: Mode Load Only Programming or Chip Select Access Programming. The chip is programmed through the address bus.

#### Initialization Period:

Once the DP8430V/31V/32V has been programmed for the first time, a 60 ms initialization period is entered. During this time the DRC performs refreshes to the DRAM array so further warm up cycles are unnecessary. The initialization period is entered only after the first programming after a reset.

#### Accessing Modes:

After resetting and programming the chip, the DP8430V/ 31V/32V is ready to access the DRAM. There are two modes of accessing with these controllers. Mode 0, which indicates RAS synchronously and Mode 1, which indicates RAS asynchronously.

#### **Refresh Modes:**

Two refresh modes can be programmed. The user can choose Automatic Internal Refresh or Externally Controlled Refresh. With any refresh mode the user can perform burst refreshes.

#### **Refresh Types:**

There are three types of refreshing available: Conventional, Staggered and Error Scrubbing. Any refresh control mode can be used with any type of refresh.

#### Wait Support:

The DP8430V/31V/32V have wait support available as DTACK or WAIT. Both are programmable. DTACK, Data Transfer ACKnowledge, is useful for processors whose wait signal is active high. WAIT is useful for those processors whose wait signal is active low. The user can choose either at programming. These signals are used by the on chip arbiter to insert wait states to guarantee the arbitration between accesses, refreshes and precharge. Both signals are independent of the access mode chosen and both signals can be dynamically delayed further through the WAITIN signal to the DP8430V/31V/32V.

#### Sequential Accesses (Static Column/Page Mode):

The DP8430V/31V/32V have address latches, used to latch the bank, row and column address inputs. Once the address is latched, a COLumn INCrement (COLINC) feature can be used to increment the column address. The address latches can also be programmed to be fall through. COLINC can be used for Sequential Accesses of Static Column DRAMs. Also, COLINC in conjunction with ECAS inputs can be used for Sequential Accesses to Page Mode DRAMs.

#### RAS and CAS Configuration (Byte Writing):

The  $\overrightarrow{RAS}$  and  $\overrightarrow{CAS}$  drivers can be configured to drive a one, two or four bank memory array up to 32 bits in width. The  $\overrightarrow{ECAS}$  signals can then be used to select one of four  $\overrightarrow{CAS}$ drivers for Byte Writing with no extra logic.

#### Memory Interleaving:

When configuring the DP8430V/31V/32V for more than one bank, Memory Interleaving can be used. By tying the low order address bits to the bank select lines B0 and B1, sequential back to back accesses will not be delayed since these controllers have separate precharge counters per bank.

#### Address Pipelining:

The DP8430V/31V/32V are capable of performing Address Pipelining. In address pipelining, the DRC will guarantee the column address hold time and switch the internal multiplexor to place the row address on the address bus. At this time, another memory access to another bank can be initiated.

#### Dual Accessing:

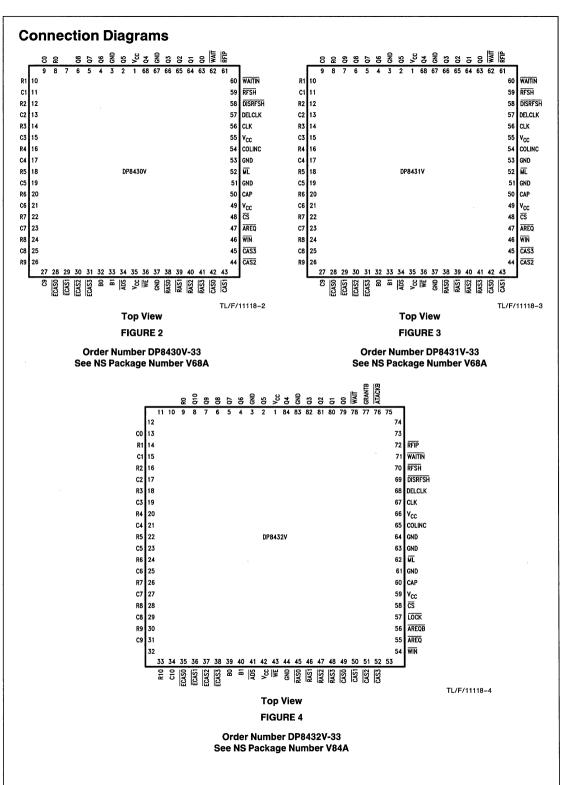
Finally, the DP8432V has all the features previously mentioned and unlike the DP8430V/31V, the DP8432V has a second port to allow a second CPU to access the same memory array. The DP8432V has four signals to support Dual Accessing, these signals are AREQB, ATACKB, LOCK and GRANTB. All arbitration for the two ports and refresh is done on chip by the controller through the insertion of wait states. Since the DP8432V has only one input address bus, the address lines must be multiplexed externally. The signal GRANTB can be used for this purpose.

#### Terminology:

The following explains the terminology used in this data sheet. The terms negated and asserted are used. Asserted refers to a "true" signal. Thus, " $\overline{\text{ECAS0}}$  asserted" means the  $\overline{\text{ECAS0}}$  input is at a logic 0. The term "COLINC asserted" means the COLINC input is at a logic 1. The term negated refers to a "false" signal. Thus, " $\overline{\text{ECAS0}}$  negated" means the  $\overline{\text{ECAS0}}$  input is at a logic 1. The term "COLINC negated" means the  $\overline{\text{ECAS0}}$  input is at a logic 1. The term "COLINC negated" means the input COLINC is at a logic 0. The term "COLINC negated" means the input COLINC is at a logic 0. The table shown below clarifies this terminology.

| Signal      | Action   | Logic Level |
|-------------|----------|-------------|
| Active High | Asserted | High        |
| Active High | Negated  | Low         |
| Active Low  | Asserted | Low         |
| Active Low  | Negated  | High        |





| Pin<br>Name           | Device (If not<br>Applicable to All) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|-----------------------|--------------------------------------|------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.1 ADDRESS           | , R/W AND PROGRA                     | AMMING S         | SIGNALS                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| R0-10<br>R0-9         | DP8432V<br>DP8430V/31V               |                  | <b>ROW ADDRESS:</b> These inputs are used to specify the row address during an access to the DRAM. They are also used to program the chip when $\overline{\text{ML}}$ is asserted (except R10).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| C0-10<br>C0-9         | DP8432V<br>DP8430V/31V               | 1                | <b>COLUMN ADDRESS:</b> These inputs are used to specify the column address during an access to the DRAM. They are also used to program the chip when $\overline{\text{ML}}$ is asserted (except C10).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| B0, B1                |                                      | I                | BANK SELECT: Depending on programming, these inputs are used to select a group of $\overrightarrow{\text{RAS}}$ and $\overrightarrow{\text{CAS}}$ outputs to assert during an access. They are also used to program the chip when $\overrightarrow{\text{ML}}$ is asserted.                                                                                                                                                                                                                                                                                                                                                                                                            |
| ECAS0-3               |                                      | I                | <b>ENABLE CAS:</b> These inputs are used to enable a single or group of CAS outputs when asserted. In combination with the B0, B1 and the programming bits, these inputs select which CAS output or CAS outputs will assert during an access. The ECAS signals can also be used to toggle a group of CAS outputs for page/nibble mode accesses. They also can be used for byte write operations. If ECAS0 is negated during programming, continuing to assert the ECAS0 while negating AREQ or AREOB during an access, will cause the CAS outputs to be extended while the RAS outputs are negated (the ECASn inputs have no effect during scrubbing refreshes).                       |
| RESET                 |                                      | I                | <b>RESET:</b> At power up, this input is used to reset the DRAM controller. The user must keep RESET low for at least 16 positive edges of clock. After programming this input must remain negated (high) to avoid an unwanted reset.                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| WIN                   |                                      | I                | <b>WRITE ENABLE IN:</b> This input is used to signify a write operation to the DRAM. If ECAS0 is asserted during programming, the $\overline{WE}$ output will follow this input. This input asserted will also cause $\overline{CAS}$ to delay to the next positive clock edge if address bit C9 is asserted during programming.                                                                                                                                                                                                                                                                                                                                                       |
| COLINC<br>(EXTNDRF)   |                                      |                  | <b>COLUMN INCREMENT:</b> When the address latches are used, and $\overrightarrow{RFIP}$ is negated, this input functions as COLINC. Asserting this signal causes the column address to be incremented by one. When $\overrightarrow{RFIP}$ is asserted, this signal is used to extend the refresh cycle by any number of periods of CLK until it is negated.                                                                                                                                                                                                                                                                                                                           |
| ML                    |                                      | I                | <b>MODE LOAD:</b> This input signal, when low, enables the internal programming register that stores the programming information.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 2.2 DRAM CO           | NTROL SIGNALS                        |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Q0-10<br>Q0-9<br>Q0-8 | DP8432V<br>DP8431V<br>DP8430V        | 0 0 0            | <b>DRAM ADDRESS:</b> These outputs are the multiplexed output of the R0–9, 10 and C0–9, 10 and form the DRAM address bus. These outputs contain the refresh address whenever $\overrightarrow{\text{RFIP}}$ is asserted. They contain high capacitive drivers with 20 $\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                                                                               |
| RAS0-3                |                                      | 0                | <b>ROW ADDRESS STROBES:</b> These outputs are asserted to latch the row address contained on the outputs Q0–8, 9, 10 into the DRAM. When RFIP is asserted, the RAS outputs are used to latch the refresh row address contained on the Q0–8, 9, 10 outputs in the DRAM. These outputs contain high capacitive drivers with 20 $\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                        |
| <u>CAS</u> 0-3        |                                      | 0                | COLUMN ADDRESS STROBES: These outputs are asserted to latch the column address contained on the outputs $QO-8$ , 9, 10 into the DRAM. These outputs have high capacitive drivers with $20\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| WE<br>(RFRQ)          |                                      | 0                | WRITE ENABLE or REFRESH REQUEST: This output asserted specifies a write operation to the DRAM. When negated, this output specifies a read operation to the DRAM. When the DP8430V/31V/32V is programmed in address pipelining mode or when ECAS0 is negated during programming, this output will function as RFRQ. When asserted, this pin specifies that 13 $\mu$ s or 15 $\mu$ s have passed. If DISRFSH is negated, the DP8430V/31V/32V will perform an internal refresh as soon as possible. If DISRFRSH is asserted, RFRQ can be used to externally request a refresh through the input RFSH. This output has a high capacitive driver and a 20 $\Omega$ series damping resistor. |

| Pin<br>Name     | Device (If not<br>Applicable to All) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-----------------|--------------------------------------|------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.3 REFRES      | SH SIGNALS                           |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| RFIP            |                                      | 0                | <b>REFRESH IN PROGRESS:</b> This output is asserted prior to a refresh cycle and is negated when all the RAS outputs are negated for that refresh.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| RFSH            |                                      | I                | <b>REFRESH:</b> This input asserted with DISRFRSH already asserted will request a refresh. If this input is continually asserted, the DP8430V/31V/32V will perform refresh cycles in a burst refresh fashion until the input is negated. If RFSH is asserted with DISRFSH negated, the internal refresh address counter is cleared (useful for burst refreshes).                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 2.4 PORT A      | ACCESS SIGNALS                       |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| ADS<br>(ALE)    |                                      | -                | ADDRESS STROBE or ADDRESS LATCH ENABLE: Depending on programming, this input can function as $\overline{\text{ADS}}$ or ALE. In mode 0, the input functions as ALE and when asserted along with $\overline{\text{CS}}$ causes an internal latch to be set. Once this latch is set an access will start from the positive clock edge of CLK as soon as possible. In Mode 1, the input functions as $\overline{\text{ADS}}$ and when asserted along with $\overline{\text{CS}}$ causes the access $\overline{\text{RAS}}$ to assert if no other event is taking place. If an event is taking place, $\overline{\text{RAS}}$ will be asserted from the positive edge of CLK as soon as possible. In both cases, the low going edge of this signal latches the bank, row and column address if programmed to do so. |
| CS              |                                      | I                | CHIP SELECT: This input signal must be asserted to enable a Port A access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| AREQ            |                                      | I                | ACCESS REQUEST: This input signal in Mode 0 must be asserted some time after the first positive clock edge after ALE has been asserted. When this signal is negated, RAS is negated for the access. In Mode 1, this signal must be asserted before ADS can be negated. When this signal is negated, RAS is negated for the access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| WAIT<br>(DTACK) |                                      | 0 0              | WAIT or DTACK: This output can be programmed to insert wait states into a CPU access cycle. With R7 negated during programming, the output will function as a WAIT type output. In this case, the output will be active low to signal a wait condition. With R7 asserted during programming, the output will function as DTACK. In this case, the output will be negated to signify a wait condition and will be asserted to signify the access has taken place. Each of these signals can be delayed by a number of positive clock edges or negative clock levels of CLK to increase the microprocessor's access cycle through the insertion of wait states.                                                                                                                                                   |
| WAITIN          |                                      | I                | WAIT INCREASE: This input can be used to dynamically increase the number of positive clock edges of CLK until DTACK will be asserted or WAIT will be negated during a DRAM access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 2.5 PORT B      | ACCESS SIGNALS                       |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| AREQB           | DP8432V<br>only                      | I                | <b>PORT B ACCESS REQUEST:</b> This input asserted will latch the row, column and bank address if programmed, and requests an access to take place for Port B. If the access can take place, RAS will assert immediately. If the access has to be delayed, RAS will assert as soon as possible from a positive edge of CLK.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| ATACKB          | DP8432V<br>only                      | 0                | ADVANCED TRANSFER ACKNOWLEDGE PORT B: This output is asserted when<br>the access RAS is asserted for a Port B access. This signal can be used to generate<br>the appropriate DTACK or WAIT type signal for Port B's CPU or bus.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |

| .6 COMMO        | Device (If not<br>Applicable to All) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|-----------------|--------------------------------------|------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                 | N DUAL PORT SIGN                     | ALS              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| GRANTB          | DP8432V<br>only                      | 0                | <b>GRANT B:</b> This output indicates which port is currently granted access to the DRAM array. When GRANTB is asserted, Port B has access to the array. When GRANTB is negated, Port A has access to the DRAM array. This signal is used to multiplex the signals R0–8, 9, 10; C0–8, 9, 10; B0–1; WIN; LOCK and ECAS0–3 to the DP8432V when using dual accessing.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| LOCK            | DP8432V<br>only                      | I                | LOCK: This input can be used by the currently granted port to "lock out" the other port from the DRAM array by inserting wait states into the locked out port's access cycle until LOCK is negated.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| .7 POWER        | SIGNALS AND CAPA                     | CITOR IN         | PUT                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| V <sub>CC</sub> |                                      | 1                | POWER: Supply Voltage.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| GND             |                                      | I                | GROUND: Supply Voltage Reference.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| САР             |                                      | 1                | <b>CAPACITOR:</b> This input is used by the internal PLL for stabilization. The value of the ceramic capacitor should be 0.1 $\mu$ F and should be connected between this input and ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| There are       |                                      |                  | V/31V/32V, CLK and DELCLK. These two clocks may both be tied to the same clock<br>s, running at different frequencies, asynchronous to each other.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| CLK             |                                      | 1                | SYSTEM CLOCK: This input may be in the range of 0 Hz up to 25 MHz. This input is generally a constant frequency but it may be controlled externally to change frequencies or perhaps be stopped for some arbitrary period of time. This input provides the clock to the internal state machine that arbitrates between accesses and refreshes. This clock's positive edges and negative levels are used to extend the WAIT (DTACK) signals. Ths clock is also used as the reference for the RAS precharge time and RAS low time during refresh. All Port A and Port B accesses are assumed to be synchronous to the system clock CLK.                                                                                                                                                                                                                                                                                                                                                          |
| DELCLK          |                                      | 1                | <b>DELAY LINE CLOCK:</b> The input frequency to DELCLK should be in the range of 12 MHz to 40 MHz. This frequency will be internally divided by choosing a divisor when programming the part. The result of the division should be a frequency of 2 MHz. This is because the Phase Lock Loop that generates the delay line assumes an input clock frequency of 2 MHz. If after dividing DELCLK by one of the internal divisors (6, 8, 10, 12, 14, 16, 18 or 20) the resulting frequency is not 2 MHz, the delay line will suffer.<br>For example, if the DELCLK frequency is 18 MHz and a divide by 8 is chosen, programming bits C0–2, the resulting frequency will be 2.25 which is 12.5% off of 2 MHz. Therefore, the DP8430V/31V/32V will produce delays that are shorter (faster delays) than what is intended. On the other hand, if divide by 10 was chosen, the resulting frequency will be 1.8 MHz, this frequency will produce delays that are longer (slower delays) than intended. |

DP8430V-33/DP8431V-33/DP8432V-33

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## 3.0 Programming and Resetting

The DP8430V/31V/32V must be reset before it can be programmed. After reset, the DRAM controller is programmed through the address bus by either one of two methods; Mode Load Only Programming or Chip Select Access Programming. After the first programming after a reset, the chip enters a 60 ms initialization period. During this period the controller performs refreshes every 13 µs or 15 µs, this makes further DRAM warm up cycles unnecessary. After this stage the DRAM controller can be programmed as many times as the user wishes and the 60 ms initialization period will not be entered into unless the chip is reset and programmed again. During the 60 ms initialization period, RFIP is asserted and RAS toggles every 13  $\mu s$  or 15  $\mu s$ depending on the programming bit for refresh (C3). CAS will be negated and the Q outputs will count from 0 to 2047 refreshing the entire DRAM array. The initialization time period is given by the following formula, T = 4096 \* (Clock)Divisor Select) \* (Refresh Clock Fine Tune)/(DELCLK Frg.)

#### 3.1 RESET

The DP8430V/31V/32V have a RESET input pin which facilitates the reset procedure required for proper operation. Reset is accomplished by asserting the RESET input for at least 16 positive edges of clock as shown in *Figure 5*.

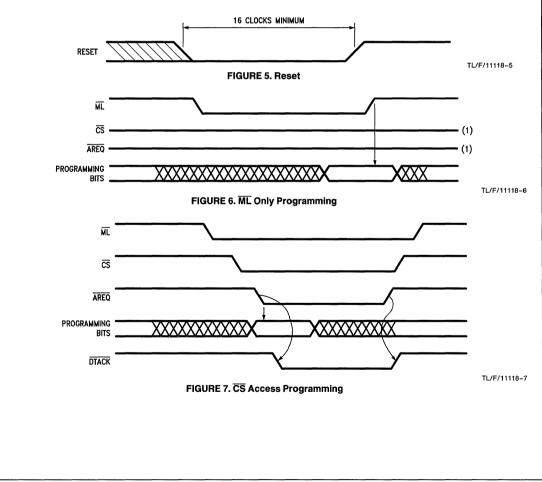
#### **3.2 PROGRAMMING METHODS**

#### 3.2.1 Mode Load Only Programming

To use this method the user asserts  $\overline{ML}$  enabling the internal programming register. After  $\overline{ML}$  is asserted, a valid programming selection is placed on the address bus, B0, B1 and ECAS0 inputs, then  $\overline{ML}$  is negated. When  $\overline{ML}$  is negated the programming bits are latched into the internal programming register and the DP8430V/31V/32V is programmed, see *Figure 6*. When programming the chip, the controller must not be refreshing,  $\overline{RFIP}$  must be high (1) to have a successful programming.

#### 3.2.2 Chip Selected Access Programming

The chip can also be programmed by performing a chip selected access. To program the chip using this method,  $\overline{\text{ML}}$  is asserted, then  $\overline{\text{CS}}$  is asserted and a valid programming selection is placed on the address bus. When  $\overline{\text{AREQ}}$  is asserted, the programming bits affecting the wait logic become effective immediately, then  $\overline{\text{DTACK}}$  is asserted allowing the access to terminate. After the access,  $\overline{\text{ML}}$  is negated and the rest of the programming bits take effect.



# DP8430V-33/DP8431V-33/DP8432V-33

## 3.0 Programming and Resetting (Continued)

#### 3.3 PROGRAMMING BIT DEFINITIONS

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| Symbol     | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ECAS0      | Extend CAS/Refresh Request Select                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| 0          | The CASn outputs will be negated with the RASn outputs when AREQ (or AREQB, DP8432V only) is negated. The WE output pin will function as write enable. Automatic Internal Refresh selected.                                                                                                                                                                                                                                                                                           |
| 1          | The CASn outputs will be negated, during an acccess (Port A (or Port B, DP8432V only)) when their corresponding ECASn inputs are negated. This feature allows the CAS outputs to be extended beyond the RAS outputs negating. Scrubbing refreshes are NOT affected. During scrubbing refreshes the CAS outputs will negate along with the RAS outputs regardless of the state of the ECAS inputs. Externally Controlled Refresh selected, WE will function as ReFresh ReQuest (RFRQ). |
| B1         | Access Mode Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 0          | ACCESS MODE 0: ALE pulsing high sets an internal latch. On the next positive edge of CLK, the access (RAS) will start. AREQ will terminate the access.<br>ACCESS MODE 1: ADS asserted starts the access (RAS) immediately. AREQ will terminate the access.                                                                                                                                                                                                                            |
| B0         | Address Latch Mode                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 0          | ADS or ALE asserted for Port A or AREQB asserted for Port B with the appropriate GRANT latch the input row, column and bank address.<br>The row, column and bank latches are fall through.                                                                                                                                                                                                                                                                                            |
| C9         | Delay CAS during WRITE Accesses                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 0<br>1     | CAS is treated the same for both READ and WRITE accesses.         During WRITE accesses, CAS will be asserted by the event that occurs last: CAS asserted by the internal delay line or CAS asserted on the positive edge of CLK after RAS is asserted.                                                                                                                                                                                                                               |
| C8         | Row Address Hold Time                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 0          | Row Address Hold Time = 25 ns minimum<br>Row Address Hold Time = 15 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                        |
| C7         | Column Address Setup Time                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 0          | Column Address Setup Time = 10 ns miniumum                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 1          | Column Address Setup Time = 0 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| C6, C5, C4 | RAS and CAS Configuration Modes/Error Scrubbing during Refresh                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 0, 0, 0    | RAS0-3 and CAS0-3 are all selected during an access. ECASn must be asserted for CASn to be asserted.         B0 and B1 are not used during an access. Error scrubbing during refresh.                                                                                                                                                                                                                                                                                                 |
| 0, 0, 1    | RAS and CAS pairs are selected during an access by B1. ECASn must be asserted for CASn to be asserted.<br>B1 = 0 during an access selects RAS0-1 and CAS0-1.<br>B1 = 1 during an access selects RAS2-3 and CAS2-3.<br>B0 is not used during an Access.                                                                                                                                                                                                                                |
| 0, 1, 0    | <ul> <li>Error scrubbing during refresh.</li> <li>RAS and CAS singles are selected during an access by B0-1. ECASn must be asserted for CASn to be asserted B1 = 0, B0 = 0 during an access selects RAS0 and CAS0.</li> <li>B1 = 0, B0 = 1 during an access selects RAS1 and CAS1.</li> <li>B1 = 1, B0 = 0 during an access selects RAS2 and CAS2.</li> <li>B1 = 1, B0 = 1 during an access selects RAS3 and CAS3.</li> <li>Error scrubbing during refresh.</li> </ul>                |
| 0, 1, 1    | RAS0-3 and CAS0-3 are all selected during an access. ECASn must be asserted for CASn to be asserted.<br>B1, B0 are not used during an access.<br>No error scrubbing. (RAS only refreshing)                                                                                                                                                                                                                                                                                            |
|            | RAS pairs are selected by B1. $\overline{CAS0}$ -3 are all selected. $\overline{ECASn}$ must be asserted for $\overline{CASn}$ to be asserted.<br>B1 = 0 during an access selects $\overline{RAS0}$ -1 and $\overline{CAS0}$ -3.                                                                                                                                                                                                                                                      |

# 3.0 Programming and Resetting (Continued)

| Symbol     | Description                                                                                                                                                                |
|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C6, C5, C4 | RAS and CAS Configuration Modes (Continued)                                                                                                                                |
| 1, 0, 1    | RAS and CAS pairs are selected by B1. ECASn must be asserted for CASn to be asserted.<br>B1 = 0 during an access selects RAS0-1 and CAS0-1.                                |
|            | B1 = 1 during an access selects $\overline{RAS}2$ -3 and $\overline{CAS}2$ -3.                                                                                             |
|            | B0 is not used during an access.                                                                                                                                           |
|            | No error scrubbing.                                                                                                                                                        |
| 1, 1, 0    | RAS singles are selected by B0-1. CAS0-3 are all selected. ECASn must be asserted for CASn to be<br>asserted.                                                              |
|            | B1 = 0, B0 = 0 during an access selects RAS0 and CAS0-3.                                                                                                                   |
|            | B1 = 0, B0 = 1 during an access selects $\overrightarrow{RAS1}$ and $\overrightarrow{CAS0}$ -3.                                                                            |
|            | B1 = 1, B0 = 0 during an access selects $\overline{RAS2}$ and $\overline{CAS0}$ -3.<br>B1 = 1, B0 = 1 during an access selects $\overline{RAS3}$ and $\overline{CAS0}$ -3. |
|            | No error scrubbing.                                                                                                                                                        |
| 1, 1, 1    | RAS and CAS singles are selected by B0, 1. ECAS must be asserted for CAS nto be asserted.                                                                                  |
| 1, 1, 1    | B1 = 0, B0 = 0 during an access selects RAS0 and CAS0.                                                                                                                     |
|            | $B1 = 0, B0 = 1$ during an access selects $\overline{RAS1}$ and $\overline{CAS1}$ .                                                                                        |
|            | B1 = 1, B0 = 0 during an access selects RAS2 and CAS2.                                                                                                                     |
|            | B1 = 1, B0 = 1 during an access selects $\overline{RAS3}$ and $\overline{CAS3}$ .                                                                                          |
|            | No error scrubbing.                                                                                                                                                        |
| C3         | Refresh Clock Fine Tune Divisor                                                                                                                                            |
| 0          | Divide delay line/refresh clock further by 30 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 15 $\mu$ s                                                                  |
|            | refresh period).                                                                                                                                                           |
| 1          | Divide delay line/refresh clock further by 26 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 13 $\mu$ s refresh period).                                                 |
| C2, C1, C0 | Delay Line/Refresh Clock Divisor Select                                                                                                                                    |
| 0, 0, 0    | Divide DELCLK by 20 to get as close to 2 MHz as possible.                                                                                                                  |
| 0, 0, 1    | Divide DELCLK by 18 to get as close to 2 MHz as possible.                                                                                                                  |
| 0, 1, 0    | Divide DELCLK by 16 to get as close to 2 MHz as possible.                                                                                                                  |
| 0, 1, 1    | Divide DELCLK by 14 to get as close to 2 MHz as possible.                                                                                                                  |
| 1, 0, 0    | Divide DELCLK by 12 to get as close to 2 MHz as possible.                                                                                                                  |
| 1, 0, 1    | Divide DELCLK by 10 to get as close to 2 MHz as possible.                                                                                                                  |
| 1, 1, 0    | Divide DELCLK by 8 to get as close to 2 MHz as possible.                                                                                                                   |
| 1, 1, 1    | Divide DELCLK by 6 to get as close to 2 MHz as possible.                                                                                                                   |
| R9         | Refresh Mode Select                                                                                                                                                        |
| 0          | RAS0-3 will all assert and negate at the same time during a refresh.                                                                                                       |
| 1          | Staggered Refresh. RAS outputs during refresh are separated by one positive clock edge. Depending on the                                                                   |
|            | configuration mode chosen, either one or two RASs will be asserted.                                                                                                        |
| R8         | Address Pipelining Select                                                                                                                                                  |
| 0          | Address pipelining is selected. The DRAM controller will switch the DRAM column address back to the row<br>address after guaranteeing the column address hold time.        |
| 1          | Non-address pipelining is selected. The DRAM controller will hold the column address on the DRAM address                                                                   |
|            | bus until the access RASs are negated.                                                                                                                                     |
| R7         | WAIT or DTACK Select                                                                                                                                                       |
| 0          | WAIT type output is selected.                                                                                                                                              |
| 1          | DTACK (Data Transfer ACKnowledge) type output is selected.                                                                                                                 |
| R6         | Add Wait States to the Current Access if WAITIN is Low                                                                                                                     |
| 0          | WAIT or DTACK will be delayed by one additional positive edge of CLK.                                                                                                      |
| 1          | WAIT or DTACK will be delayed by two additional positive edges of CLK.                                                                                                     |

# 3.0 Programming and Resetting (Continued)

3.3 PROGRAMMING BIT DEFINITIONS (Continued)

.....

| Symbol | Description                                                                                                                                                                                                                                                         |
|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R5, R4 | WAIT/DTACK during Burst (See Section 5.1.2 or 5.2.2)                                                                                                                                                                                                                |
| 0, 0   | NO WAIT STATES; If $R7 = 0$ during programming, WAIT will remain negated during burst portion of access.<br>If $R7 = 1$ programming, DTACK will remain asserted during burst portion of access.                                                                     |
| 0, 1   | 1T; If $R7 = 0$ during programming, WAIT will assert when the ECAS inputs are negated with AREQ asserted.<br>WAIT will negate from the positive edge of CLK after the ECASs have been asserted.                                                                     |
|        | If $R7 = 1$ during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted.<br>DTACK will assert from the positive edge of CLK after the ECASs have been asserted.                                                                       |
| 1,0    | $\frac{1}{2}$ T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated with AREQ asserted.<br>WAIT will negate on the negative level of CLK after the ECASs have been asserted.                                                           |
|        | If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted.<br>DTACK will assert from the negative level of CLK after the ECASs have been asserted.                                                                        |
| 1, 1   | 0T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated. WAIT will negate when the ECAS inputs are asserted.                                                                                                                            |
|        | If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated. DTACK will assert when the ECAS inputs are asserted.                                                                                                                              |
| R3, R2 | WAIT/DTACK Delay Times (See Section 5.1.1 or 5.2.1)                                                                                                                                                                                                                 |
| 0, 0   | NO WAIT STATES; If R7 = 0 during programming, WAIT will remain high during non-delayed accesses. WAIT will negate when RAS is negated during delayed accesses.<br>NO WAIT STATES; If R7 = 1 during programming, DTACK will be asserted when RAS is asserted.        |
| 0, 1   | $\frac{1}{2}$ T; If R7 = 0 during programming, WAIT will negate on the negative level of CLK, after the access RAS.                                                                                                                                                 |
| 1,0    | 1T; If $R7 = 1$ during programming, DTACK will be asserted on the positive edge of CLK after the access RAS.<br>NO WAIT STATES, $\frac{1}{2}$ ; If $R7 = 0$ during programming, WAIT will remain high during non-delayed accesses.                                  |
| 1,0    | WAIT will negate on the negative level of CLK, after the access $\overline{RAS}$ , during delayed accesses.<br>$\frac{1}{2}$ ; if $R7 = 1$ during programming, $\overline{DTACK}$ will be asserted on the negative level of CLK after the access $\overline{RAS}$ . |
| 1, 1   | $7_{21}$ , $177 = 1$ during programming, DTAOK will be asserted on the negative rever of OLK after the access TAS.<br>1T; If R7 = 0 during programming, WAIT will negate on the positive edge of CLK after the access TAS.                                          |
|        | $1\frac{1}{2}$ T; If R7 = 1 during programming, DTACK will be asserted on the negative level of CLK after the positive edge of CLK after the access RAS.                                                                                                            |
| R1, R0 | RAS Low and RAS Precharge Time                                                                                                                                                                                                                                      |
| 0, 0   | $\overline{RAS}$ asserted during refresh = 2 positive edges of CLK.<br>$\overline{RAS}$ precharge time = 1 positive edge of CLK.                                                                                                                                    |
| 0, 1   | $\overline{\text{RAS}}$ will start from the first positive edge of CLK after GRANTB transitions (DP8432V).<br>$\overline{\text{RAS}}$ asserted during refresh = 3 positive edges of CLK.                                                                            |
| ·      | RAS precharge time = 2 positive edges of CLK.                                                                                                                                                                                                                       |
| 1,0    | RAS will start from the second positive edge of CLK after GRANTB transitions (DP8432V).<br>RAS asserted during refresh = 2 positive edges of CLK.                                                                                                                   |
| ., •   | $\overline{RAS}$ precharge time = 2 positive edges of CLK.                                                                                                                                                                                                          |
| 1, 1   | $\overline{RAS}$ will start from the first positive edge of CLK after GRANTB transitions (DP8432V).<br>$\overline{RAS}$ asserted during refresh = 4 positive edges of CLK.                                                                                          |
| ', '   | $\overline{RAS}$ precharge time = 3 positive edges of CLK.                                                                                                                                                                                                          |
|        | RAS will start from the second positive edge of CLK after GRANTB transitions (DP8432V).                                                                                                                                                                             |
|        |                                                                                                                                                                                                                                                                     |
|        |                                                                                                                                                                                                                                                                     |
|        |                                                                                                                                                                                                                                                                     |
|        |                                                                                                                                                                                                                                                                     |
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|        |                                                                                                                                                                                                                                                                     |

## 4.0 Port A Access Modes

The DP8430V/31V/32V have two general purpose access modes. Mode 0 RAS synchronous and Mode 1 RAS asynchronous. One of these modes is selected at programming through the B1 input. A Port A access to DRAM is initiated by two input signals:  $\overline{ADS}$  (ALE) and  $\overline{CS}$ . The access is always terminated by one signal:  $\overline{AREQ}$ . These input signals should be synchronous to the input clock.

#### 4.1 ACCESS MODE 0

Mode 0, synchronous access, is selected by negating the input B1 during programming (B1=0). To initiate a Mode 0 access, ALE is pulse high and  $\overline{\rm CS}$  is asserted. If precharge time was met, a refresh of DRAM or a Port B access was not in progress, the  $\overline{\rm RAS}$  ( $\overline{\rm RAS}$ s) would be asserted on the

first rising edge of clock. If a refresh or a Port B access is in progress or precharge time is required, the controller will wait until these events have taken place and assert  $\overrightarrow{\text{RAS}}$  ( $\overrightarrow{\text{RASs}}$ ) on the next positive edge of clock.

Sometime after the first positive edge of clock after ALE and  $\overline{CS}$  have been asserted, the input  $\overline{AEC}$  must be asserted. In single port applications, once  $\overline{AEC}$  is asserted,  $\overline{CS}$  can be negated. On the other hand, ALE can stay asserted several periods of clock; however, ALE must be negated before or during the period of CLK in which  $\overline{AEC}$  is negated.

The controller samples  $\overline{\text{AREQ}}$  on the every rising edge of clock after  $\overline{\text{DTACK}}$  is asserted. The access will end when  $\overline{\text{AREQ}}$  is sampled negated.

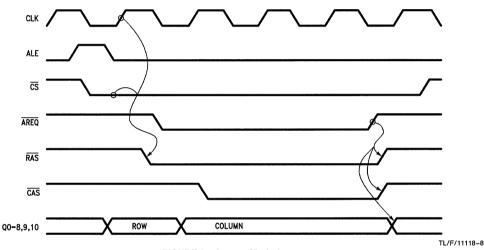


FIGURE 8a. Access Mode 0

#### 4.2 ACCESS MODE 1

Mode 1, asynchronous access, is selected by asserting the input B1 during programming (B1=1). This mode allows accesses to start immediately from the access request input,  $\overline{ADS}$ . To initiate a Mode 1 access,  $\overline{CS}$  is asserted followed by  $\overline{ADS}$  asserted. If precharge time was met, a refresh of the DRAM or a Port B access was not in progress, the  $\overline{RAS}$  ( $\overline{RASs}$ ) would be asserted from  $\overline{ADS}$  being asserted. If a refresh or Port B access is in progress or precharge time is required, the controller will wait until these events have tak-

en place and assert  $\overline{\text{RAS}}$  ( $\overline{\text{RASs}}$ ) from the next rising edge of clock.

When  $\overline{\text{ADS}}$  is asserted or sometime after,  $\overline{\text{AREQ}}$  must be asserted. At this time,  $\overline{\text{ADS}}$  can be negated and  $\overline{\text{AREQ}}$  will continue the access. Also,  $\overline{\text{ADS}}$  can continue to be asserted after  $\overline{\text{AREQ}}$  has been asserted and negated; however, a new access will not start until  $\overline{\text{ADS}}$  is negated and asserted again. When address pipelining is not implemented,  $\overline{\text{ADS}}$  and  $\overline{\text{AREQ}}$  can be tied together.

The access will end when AREQ is negated.

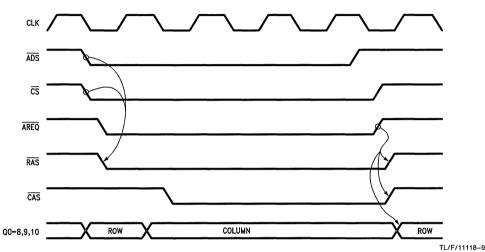


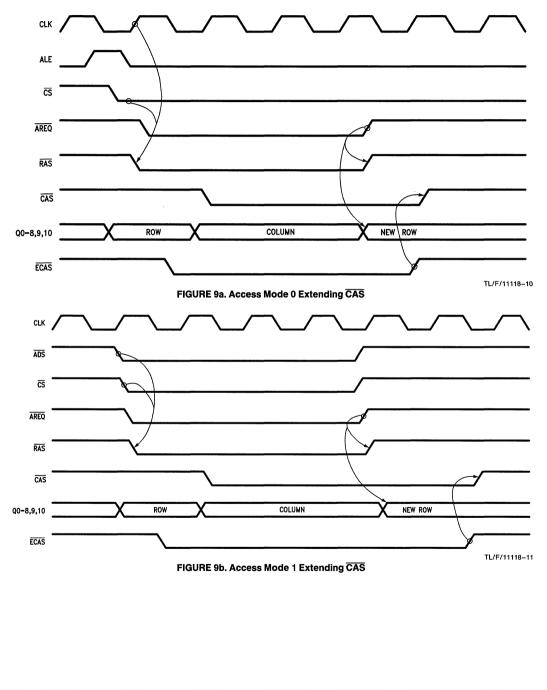
FIGURE 8b. Access Mode 1

1

#### 4.3 EXTENDING CAS WITH EITHER ACCESS MODE

In both access modes, once  $\overline{\text{AREQ}}$  is negated,  $\overline{\text{RAS}}$  and  $\overline{\text{DTACK}}$  if programmed will be negated. If  $\overline{\text{ECASO}}$  was asserted (0) during programming,  $\overline{\text{CAS}}$  ( $\overline{\text{CASs}}$ ) will be negated

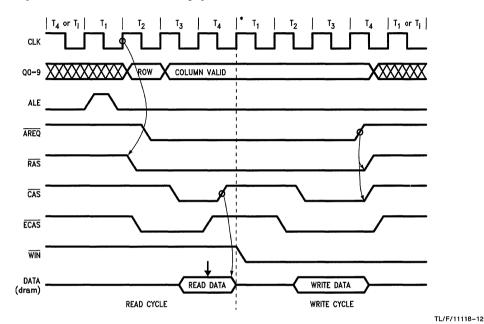
with  $\overline{\text{AREQ.}}$  If  $\overline{\text{ECAS0}}$  was negated (1) during programming,  $\overline{\text{CAS}}$  ( $\overline{\text{CASs}}$ ) will continue to be asserted after  $\overline{\text{RAS}}$  has been negated, given that the appropriate  $\overline{\text{ECAS}}$  inputs are asserted. This allows a DRAM to have data present on the data out bus while gaining  $\overline{\text{RAS}}$  precharge time.



#### 4.4 READ-MODIFY-WRITE CYCLES WITH EITHER ACCESS MODE

There are 2 methods by which this chip can be used to do read-modify-write access cycles. The first method involves doing a late write access where the  $\overline{\text{WIN}}$  input is asserted some delay after  $\overline{\text{CAS}}$  is asserted. The second method involves doing a page mode read access followed by a page mode write access with  $\overline{\text{RAS}}$  held low (see *Figure 9c*).

CASn must be toggled using the ECASn inputs and WIN has to be changed from negated to asserted (read to write) while CAS is negated. This method is better than changing WIN from negated to asserted in a late write access because here a problem may arise with DATA IN and DATA OUT being valid at the same time. This may result in a data line trying to drive two different levels simultaneously. The page mode method of a read-modify-write access allows the user to have transceivers in the system because the data in (read data) is guaranteed to be high impedance during the time the data out (write data) is valid.



\*There may be idle states inserted here by the CPU.

#### FIGURE 9c. Read-Modify-Write Access Cycle

1

#### 4.5 ADDITIONAL ACCESS SUPPORT FEATURES

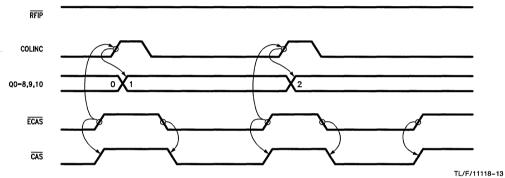
To support the different modes of accessing, the DP8430V/ 31V/32V offer other access features. These additional features include: Address Latches and Column Increment (for page/burst mode support), Address Pipelining, and Delay  $\overline{CAS}$  (to allow the user with a multiplexed bus to ensure valid data is present before  $\overline{CAS}$  is asserted).

#### 4.5.1 Address Latches and Column Increment

The Address Latches can be programmed, through programming bit B0. They can be programmed to either latch the address or remain in a fall-through mode. If the address latches are used to latch the address, the controller will function as follows:

In Mode 0, the rising edge of ALE places the latches in fallthrough, once ALE is negated, the address present in the row, column and bank input is latched. In Mode 1, the address latches are in fall through mode until  $\overline{\text{ADS}}$  is asserted.  $\overline{\text{ADS}}$  asserted latches the address.

Once the address is latched, the column address can be incremented with the input COLINC. COLINC can be used for sequential accesses of static column DRAMs. COLINC can also be used with the ECAS inputs to support sequential accesses to page mode DRAMs as shown in *Figure 10*. COLINC should only be asserted when the signal RFIP is negated during an access since this input functions as extended refresh when RFIP is asserted. COLINC must be negated (0) when the address is being latched (ADS falling edge in Mode 1). If COLINC is asserted with all of the bits of the column address asserted (ones), the column address will return to zero.



#### FIGURE 10. Column Increment

The address latches function differently with the DP8432V. The DP8432V will latch the address of the currently granted port. If Port A is currently granted, the address will be latched as described in Section 4.5.1. If Port A is not granted, and requests an access, the address will be latched on the first or second positive edge of CLK after GRANTB has been negated depending on the programming bits R0, R1. For Port B, if GRANTB is asserted, the address will be latched with AREQB asserted. If GRANTB is negated, the address will latch on the first or second positive edge of CLK after GRANTB is asserted depending on the programming bits R0, R1.

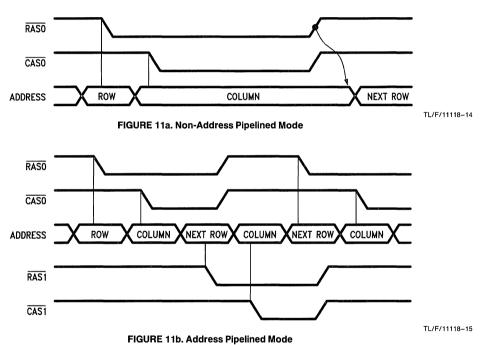
#### 4.5.2 Address Pipelining

Address pipelining is the overlapping of accesses to different banks of DRAM. If the majority of successive accesses are to a different bank, the accesses can be overlapped. Because of this overlapping, the cycle time of the DRAM accesses are greatly reduced. The DP8430V/31V/32V can be programmed to allow a new row address to be placed on the DRAM address bus after the column address hold time has been met. At this time, a new access can be initiated with ADS or ALE, depending on the access mode, while AREQ is used to sustain the current access. The DP8432V supports address pipelining for Port A only. This mode cannot be used with page, static column or nibble modes of operations because the DRAM column address is switched back to the row address after CAS is asserted. This mode is programmed through address bit R8 (see Figures 11a and 11b).

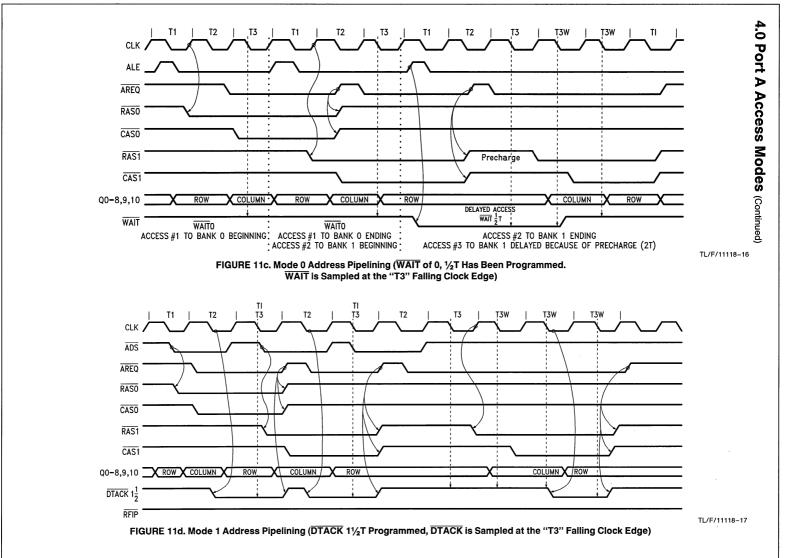
During address pipelining in Mode 0, shown in *Figure 11c*, ALE cannot be pulsed high to start another access until  $\overline{AREQ}$  has been asserted for the previous access for at least one period of CLK. DTACK, if programmed, will be negated once  $\overline{AREQ}$  is negated. WAIT, if programmed to insert wait states, will be asserted once ALE and  $\overline{CS}$  are asserted.

In Mode 1, shown in *Figure 11d*, ADS can be negated once AREQ is asserted. After meeting the minimum negated pulse width for ADS, ADS can again be asserted to start a new access. DTACK, if programmed, will be negated once AREQ is negated. WAIT, if programmed, will be asserted once ADS is asserted.

In either mode with either type of wait programmed, the DP8430V/31V/32V will still delay the access for precharge if sequential accesses are to the same bank or if a refresh takes place.



#### DP8430V-33/DP8431V-33/DP8432V-33



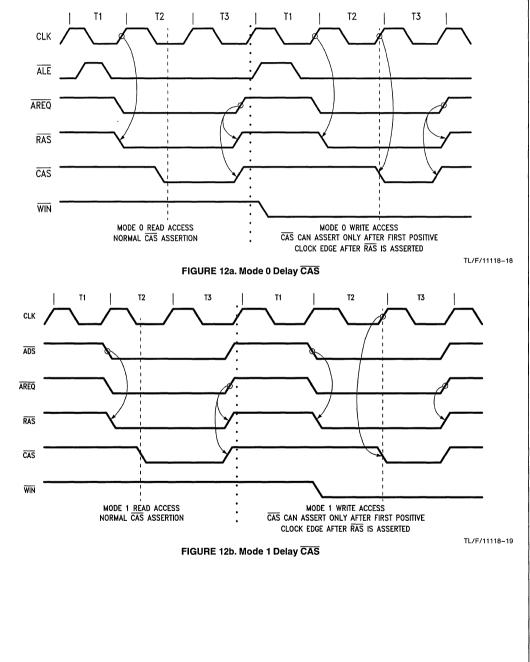
1-224

#### 4.5.3 Delay CAS during Write Accesses

-

Address bit C9 asserted during programming will cause  $\overline{CAS}$  to be delayed until the first positive edge of CLK after  $\overline{RAS}$  is asserted when the input  $\overline{WIN}$  is asserted. Delaying  $\overline{CAS}$  during write accesses ensures that the data to be written to DRAM will be setup to  $\overline{CAS}$  asserting as shown in *Figures* 

12a and 12b. If the possibility exists that data still may not be present after the first positive edge of CLK,  $\overline{CAS}$  can be delayed further with the  $\overline{ECAS}$  inputs. If address bit C9 is negated during programming, read and write accesses will be treated the same (with regard to  $\overline{CAS}$ ).



## 5.0 Refresh Options

The DP8430V/31V/32V support two refresh control mode options:

- 1. Automatic Internally Controlled Refresh.
- 2. Externally Controlled Refresh.

With each of the control modes above, three types of refresh can be performed.

- 1. All RAS Refresh.
- 2. Staggered Refresh.
- 3. Error Scrubbing During All RAS Refresh.

There are two inputs, EXTNDRF and RFSH and two outputs, RFIP and RFRQ, associated with refresh. There are also ten programming bits: R0–1, R9, C0–6 and ECAS0 used to program the various types of refreshing.

Asserting the input EXTNDRF, extends the refresh cycle for a single or multiple integral periods of CLK.

The output  $\overrightarrow{\text{RFIP}}$  is asserted one period of CLK before the first refresh  $\overrightarrow{\text{RAS}}$  is asserted. If an access is currently in progress,  $\overrightarrow{\text{RFIP}}$  will be asserted up to one period of CLK before the first refresh  $\overrightarrow{\text{RAS}}$ , after  $\overrightarrow{\text{AREQ}}$  or  $\overrightarrow{\text{AREQB}}$  is negated for the access (see *Figure 13*).

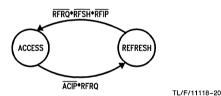
The DP8430V/31V/32V will increment the refresh address counter automatically, independent of the refresh mode used. The refresh address counter will be incremented once all the refresh  $\overline{\text{RASs}}$  have been negated.

In every combination of refresh control mode and refresh type, the DP8430V/31V/32V is programmed to keep  $\overline{RAS}$  asserted a number of CLK periods. The time values of  $\overline{RAS}$  low during refresh are programmed through programming bits R0 and R1.

#### 5.1 REFRESH CONTROL MODES

#### 5.1.1. Automatic Internal Refresh

To select Automatic Internal Refresh, the user must choose  $\overline{ECASO} = 0$  during programming. The DP8430V/31V/32V have an internal refresh clock. The period of the refresh clock is generated from the programming bits CO-3. Every period of the refresh clock, an internal refresh request is generated. As long as a DRAM access is not currently in progress and precharge time has been met, the internal refresh request will generate an automatic internal refresh. If a DRAM access is in progress, the DP8430V/31V/32V on-chip arbitration logic will wait until the access is finished before performing the refresh. The refresh/access arbitration logic can insert a refresh cycle between two address pipelined accesses. However, the refresh arbitration logic can not interrupt an access cycle to perform a refresh.



Explanation of Terms

- RFRQ = ReFresh ReQuest internal to the DP8430V/31V/32V. RFRQ has the ability to hold off a pending access.
- RFSH = Externally requested ReFreSH
- RFIP = ReFresh in Progress
- ACIP = Port A or Port B (DP8432V only) ACcess in Progress. This means that either RAS is low for an access or is in the process of transitioning low for an access.

#### FIGURE 13. DP8430V/31V/32V Access/Refresh Arbitration State Program

#### 5.1.2 Externally Controlled Refresh Mode

To choose this refresh mode, the user must program  $\overline{\text{ECASO}} = 1$ . When this mode is selected, the user is responsible for generating refresh requests by asserting the input  $\overline{\text{RFSH}}$  every time a refresh cycle is to be performed. In this refresh mode, the output  $\overline{\text{WE}}$  functions a  $\overline{\text{RFRQ}}$ .

When Externally Controlled Refresh is selected, the user may choose to monitor the output ReFresh ReQuest

(RFRQ) for an indication from the DRAM controller that a refresh is needed. When this output asserts, it indicates that the internal refresh clock has expired and that another refresh is necessary. Then the user has two options. First, he can answer immediately asserting the input RFSH requesting a refresh cycle. In this case a refresh will take place immediately if no access has been met. See *Figure 14a*.

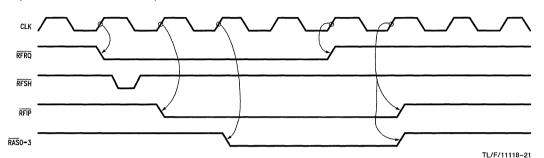


FIGURE 14a. Automatic Internal Refresh with Refresh Request (3T of RAS Low during Refresh Programmed)

Second, the user may choose not to assert the RFSH input delaying the refresh until later. RFRQ will go high and then assert (toggle) if additional periods of the internal refresh clock have expired and the user has not performed a refresh by asserting the input RFSH. See *Figure 14b*. If a time critical event, or a long access like page or static column

mode can not be interrupted,  $\overline{\text{RFRQ}}$  pulsing high can be used to increment an external counter. This counter can later be used to perform a burst refresh of the number of refreshes missed (through the  $\overline{\text{RFSH}}$  input). This scheme can be thought of as Refresh Request/Acknowledge.

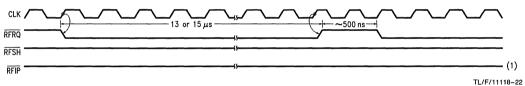
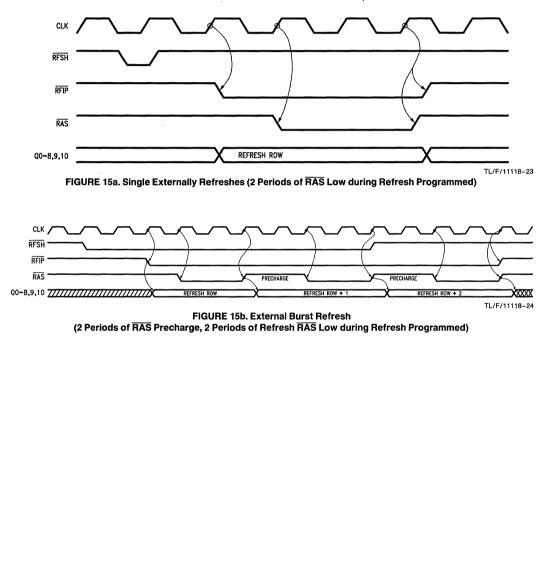


FIGURE 14b. Refresh Request Timing

In Externally Controlled Refresh the user does not have to wait for  $\overline{\text{RFRQ}}$  to perform a refresh. The user can at any time assert the  $\overline{\text{RFSH}}$  input. Pulsing  $\overline{\text{RFSH}}$  low, sets an internal latch that is used to produce the internal refresh request. The refresh cycle will take place on the next positive edge of clock, as shown in *Figure 15a*. If an access to the DRAM is in progress or precharge time for the last access has not been met, the refresh will be delayed. Since pulsing  $\overline{\text{RFSH}}$  low sets a latch, the user doesn't have to keep  $\overline{\text{RFSH}}$  low until the refresh starts. When the last refresh  $\overline{\text{RAS}}$  negates, the internal refresh request latch is cleared.

By keeping the input  $\overline{\text{RFSH}}$  asserted past the positive edge of CLK which ends the refresh cycle as shown in *Figure 15b*, the user will perform another refresh cycle. Each refresh cycle during a burst refresh will meet the refresh  $\overline{\text{RAS}}$ low time and the  $\overline{\text{RAS}}$  precharge time (programming bits RO-1). This scheme can be thought of as Externally Controlled Burst Refresh. If the user desires to burst refresh the entire DRAM, he could generate an end of count signal (burst refresh finished), by looking at one of the DP8430V/ 31V/32V high address outputs (Q7, Q8, Q9 or Q10) and the  $\overline{\text{RFIP}}$  output. The Qn outputs function as a decode of how many row addresses have been refreshed. (Q7 = 128 refreshes, Q8 = 256 refreshes, Q9 = 512 refreshes and Q10 = 1024 refreshes).



#### **5.2 REFRESH CYCLE TYPES**

Three different types of refresh cycles are available for use. The three different types are mutually exclusive and can be used with any of the three modes of refresh control. The three different refresh cycle types are: all RAS refresh, staggered RAS refresh and error scrubbing during all RAS refresh. In all refresh cycle types, the RAS precharge time is guaranteed: between the previous access RAS ending and the refresh RAS0 starting; between refresh RAS3 ending and access RAS beginning; between burst refresh RAS3.

#### 5.2.1 Conventional RAS Refresh

A conventional refresh cycle causes  $\overline{RAS0}$ -3 to all assert from the first positive edge of CLK after  $\overline{RFIP}$  is asserted as shown in *Figure 16*.  $\overline{RAS0}$ -3 will stay asserted until the number of positive edges of CLK programmed have passed. On the last positive edge,  $\overline{RAS0}$ -3, and  $\overline{RFIP}$  will be negated. This type of refresh cycle is programmed by negating address bit R9 during programming.

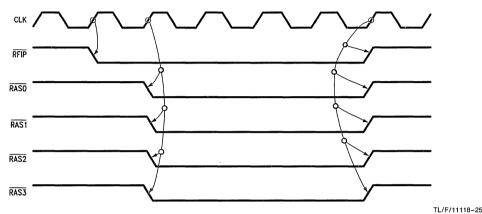
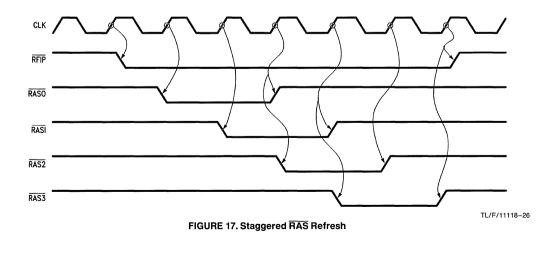


FIGURE 16. Conventional RAS Refresh

#### 5.2.2 Staggered RAS Refresh

A staggered refresh staggers each  $\overline{\text{RAS}}$  or group of  $\overline{\text{RASs}}$  by a positive edge of CLK as shown in *Figure 17*. The number of  $\overline{\text{RASs}}$ , which will be asserted on each positive edge of CLK, is determined by the  $\overline{\text{RAS}}$  ( $\overline{\text{CAS}}$  configuration mode programming bits C4–C6. If single  $\overline{\text{RAS}}$  outputs are selected during programming, then each  $\overline{\text{RAS}}$  will assert on successive positive edges of CLK. If two  $\overline{\text{RAS}}$  outputs are selected during programming then  $\overline{\text{RAS}}$  on  $\overline{\text{RAS}}$  in will assert

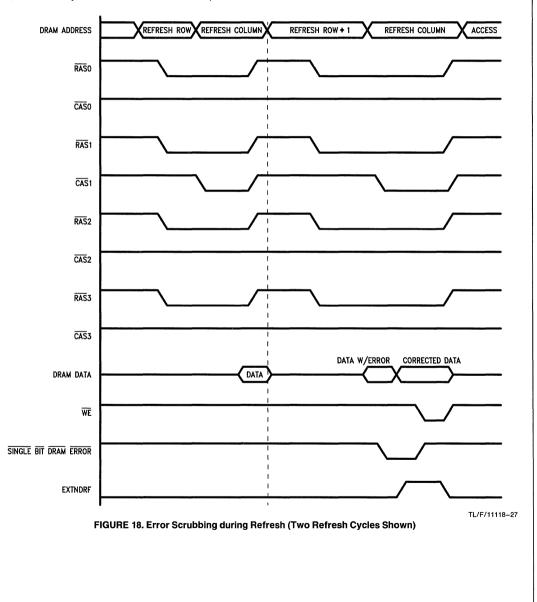
on the first positive edge of CLK after  $\overline{\text{RFIP}}$  is asserted.  $\overline{\text{RAS2}}$  and  $\overline{\text{RAS3}}$  will assert on the second positive edge of CLK after  $\overline{\text{RFIP}}$  is asserted. If all  $\overline{\text{RAS}}$  outputs were selected during programming, all  $\overline{\text{RAS}}$  outputs would assert on the first positive edge of CLK after  $\overline{\text{RFIP}}$  is asserted. Each  $\overline{\text{RAS}}$ or group of  $\overline{\text{RASs}}$  will meet the programmed  $\overline{\text{RAS}}$  low time and then negate.



#### 5.2.3 Error Scrubbing during Refresh

The DP8430V/31V/32V support error scrubbing during all RAS DRAM refreshes. Error scrubbing during refresh is selected through bits C4–C6 with bit R9 negated during programming. Error scrubbing can not be used with staggered refresh (see Section 8.0). Error scrubbing during refresh allows a CAS or group of CASs to assert during the all RAS refresh as shown in *Figure 18*. This allows data to be read from the DRAM array and passed through an Error Detection And Correction Chip, EDAC. If the EDAC determines that the data contains a single bit error and corrects that error, the refresh cycle can be extended with the input ext

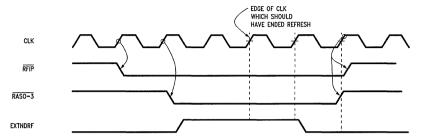
tend refresh, EXTNDRF, and a read-modify-write operation can be performed by asserting  $\overline{WE}$ . It is the responsibility of the designer to ensure that  $\overline{WE}$  is negated. The DP8432V has a 24-bit internal refresh address counter that contains the 11 row, 11 column and 2 bank addresses. The DP8430V/31V have a 22-bit internal refresh address counter that contains the 10 row, 10 column and 2 bank addresses. These counters are configured as bank, column, row with the row address as the least significant bits. The bank counter bits are then used with the programming selection to determine which  $\overline{CAS}$  or group of  $\overline{CASs}$  will assert during a refresh.



#### 5.3 EXTENDING REFRESH

The programmed number of periods of CLK that refresh  $\overline{RASs}$  are asserted can be extended by one or multiple periods of CLK. Only the all  $\overline{RAS}$  (with or without error scrubbing) type of refresh can be extended. To extend a refresh cycle, the input extend refresh, EXTNDRF, must be asserted before the positive edge of CLK that would have negated

all the  $\overline{\text{RAS}}$  outputs during the refresh cycle and after the positive edge of CLK which starts all  $\overline{\text{RAS}}$  outputs during the refresh as shown in *Figure 19*. This will extend the refresh to the next positive edge of CLK and EXTNDRF will be sampled again. The refresh cycle will continue until EXTNDRF is sampled low on a positive edge of CLK.



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FIGURE 19. Extending Refresh with the Extend Refresh (EXTNDRF) Input

## 6.0 Port A Wait State Support

Wait states allow a CPU's access cycle to be increased by one or multiple CPU clock periods. The wait or ready input is named differently by CPU manufacturers. However, any CPU's wait or ready input is compatible with either the WAIT or DTACK output of the DP8430V/31V/32V. The user determines whether to program WAIT or DTACK (R7) and which value to select for WAIT or DTACK (R2, R3) depending upon the CPU used and where the CPU samples its wait input during an access cycle.

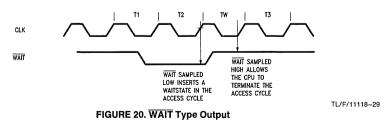
The decision to terminate the CPU access cycle is directly affected by the speed of the DRAMs used. The system designer must ensure that the data from the DRAMs will be present for the CPU to sample or that the data has been written to the DRAM before allowing the CPU access cycle to terminate.

The insertion of wait states also allows a CPU's access cycle to be extended until the DRAM access has taken place. The DP8430V/31V/32V insert wait states into CPU access cycles due to; guaranteeing precharge time, refresh currently in progress, user programmed wait states, the WAITIN signal being asserted and GRANTB not being valid (DP8432V only). If one of these events is taking place and the CPU starts an access, the DP8430V/31V/32V will insert wait states into the access cycle, thereby increasing the length of the CPU's access. Once the event has been completed, the DP8430V/31V/32V will allow the access to take place and stop inserting wait states.

There are six programming bits, R2-R7; an input, WAITIN; and an output that functions as WAIT or DTACK.

#### 6.1 WAIT TYPE OUTPUT

With the R7 address bit negated during programming, the user selects the WAIT output. As long as WAIT is sampled asserted by the CPU, wait states (extra clock periods) are inserted into the current access cycle as shown in Figure 20. Once WAIT is sampled negated, the access cycle is completed by the CPU. WAIT is asserted at the beginning of a chip selected access and is programmed to negate a number of positive edges and/or negative levels of CLK from the event that starts the access. WAIT can also be programmed to function in page/burst mode applications. Once WAIT is negated during an access, and the ECAS inputs are negated with AREQ asserted, WAIT can be proarammed to toggle, following the ECAS inputs. Once AREQ is negated, ending the access, WAIT will stay negated until the next chip selected access. For more details about WAIT Type Output, see Application Note AN-773.

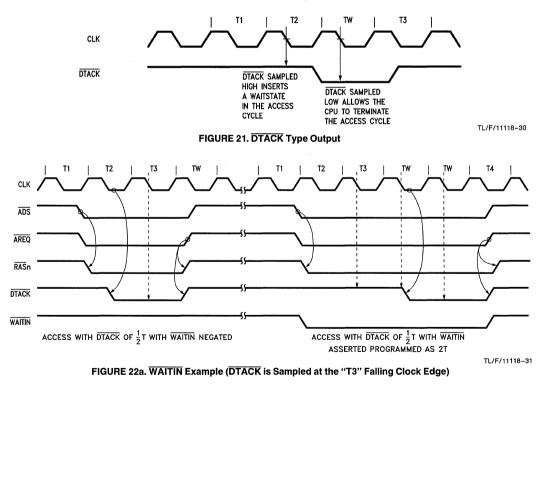


## 6.0 Port A Wait State Support (Continued) 6.2 DTACK TYPE OUTPUT

With the R7 address bit asserted during programming, the user selects the DTACK type output. As long as DTACK is sampled negated by the CPU, wait states are inserted into the current access cycle as shown in Figure 21. Once DTACK is sampled asserted, the access cycle is completed by the CPU. DTACK, which is normally negated, is programmed to assert a number of positive edges and/or negative levels from the event that starts RAS for the access. DTACK can also be programmed to function during page/ burst mode accesses. Once DTACK is asserted and the ECAS inputs are negated with AREQ asserted, DTACK can be programmed to negate and assert from the ECAS inputs toggling to perform a page/burst mode operation. Once AREQ is negated, ending the access, DTACK will be negated and stays negated until the next chip selected access. For more details about DTACK type output see Application Note AN-773.

#### 6.3 DYNAMICALLY INCREASING THE NUMBER OF WAIT STATES

The user can increase the number of positive edges of CLK before DTACK is asserted or WAIT is negated. With the input WAITIN asserted, the user can delay DTACK asserting or WAIT negating either one or two more positive edges of CLK. The number of edges is programmed through address bit R6. If the user is increasing the number of positive edges in a delay that contains a negative level, the positive edges will be met before the negative level. For example if the user programmed DTACK of 1/2T, asserting WAITIN, programmed as 2T, would increase the number of positive edges resulting in DTACK of 21/2T as shown in Figure 22a. Similarly, WAITIN can increase the number of positive edges in a page/burst access. WAITIN can be permanently asserted in systems requiring an increased number of wait states. WAITIN can also be asserted and negated, depending on the type of access. As an example, a user could invert the WRITE line from the CPU and connect the output to WAITIN. This could be used to perform write accesses with 1 wait state and read accesses with 2 wait states as shown in Figure 22b.



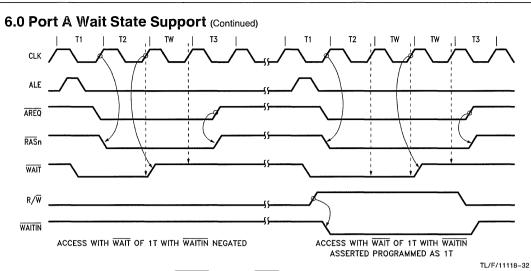


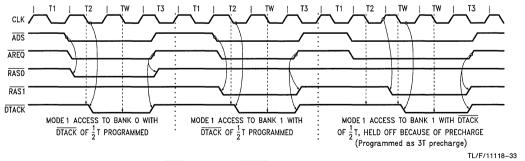
FIGURE 22b. WAITIN Example (WAIT is Sampled at the End of "T2").

#### 6.4 GUARANTEEING RAS LOW TIME AND RAS PRECHARGE TIME

The DP8430V/31V/32V will guarantee  $\overline{\text{RAS}}$  precharge time between accesses; between refreshes; and between access and refreshes. The programming bits R0 and R1 are used to program combinations of  $\overline{\text{RAS}}$  precharge time and  $\overline{\text{RAS}}$  low time referenced by positive edges of CLK.  $\overline{\text{RAS}}$  low time is programmed for refreshes only. During an access, the system designer guarantees the time  $\overline{\text{RAS}}$  is asserted through the DP8430V/31V/32V wait logic. Since inserting wait states into an access increases the length of the CPU signals which are used to create  $\overline{\text{ADS}}$  or ALE and  $\overline{\text{AREQ}}$ , the time that  $\overline{\text{RAS}}$  is asserted can be guaranteed.

The precharge time is also guaranteed by the DP8430V/ 31V/32V. Each  $\overline{\text{RAS}}$  output has a separate positive edge

of CLK counter.  $\overline{AREQ}$  is negated setup to a positive edge of CLK to terminate the access. That positive edge is 1T. The next positive edge is 2T.  $\overline{RAS}$  will not be asserted until the programmed number of positive edges of CLK have passed as shown in *Figure 23*. Once the programmed precharge time has been met,  $\overline{RAS}$  will be asserted from the positive edge of CLK. However, since there is a precharge counter per  $\overline{RAS}$ , an access using another  $\overline{RAS}$  will not be delayed. Precharge time before a refresh is always referenced from the access  $\overline{RAS}$  negating before  $\overline{RAS}$  for the refresh asserting. After a refresh, precharge time is referenced from  $\overline{RAS3}$  negating, for the refresh, to the access  $\overline{RAS}$  asserting.





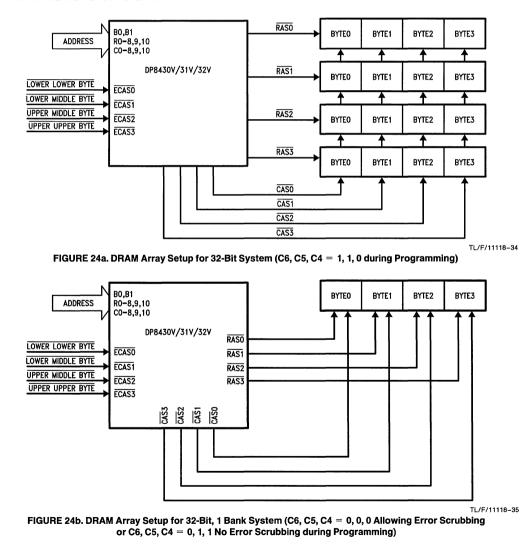
DP8430V-33/DP8431V-33/DP8432V-33

# 7.0 $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ Configuration Modes

The DP8430V/31V/32V allow the user to configure the DRAM array to contain one, two or four banks of DRAM. Depending on the functions used, certain considerations must be used when determining how to set up the DRAM array. Programming address bits C4, C5 and C6 along with bank selects, B0–1, and CAS enables, ECAS0–3, determine which RAS or group of RASs and which CAS or group of CASs will be asserted during an access. Different memory schemes are described. The DP8430V/31V/32V is specified driving a heavy load of 72 DRAMs, representing four banks of DRAM with 16-bit words and 2 parity bits. The DP8430V/31V/32V can drive more than 72 DRAMs, but the AC timing must be increased. Since the RAS and CAS outputs are configurable, all RAS and CAS outputs should be used for the maximum amount of drive.

#### 7.1 BYTE WRITING

By selecting a configuration in which all  $\overline{CAS}$  outputs are selected during an access, the  $\overline{ECAS}$  inputs enable a single or group of  $\overline{CAS}$  outputs to select a byte (or bytes) in a word size of up to 32 bits. In this case, the  $\overline{RAS}$  outputs are used to select which of up to 4 banks is to be used as shown in *Figures 24a* and *24b*. In systems with a word size of 16 bits, the byte enables can be gated with a high order address bit to produce four byte enables which gives an equivalent to 8 banks of 16-bit words as shown in *Figure 24d*. If less memory is required, each  $\overline{CAS}$  should be used to drive each nibble in the 16-bit word as shown in *Figure 24c*.



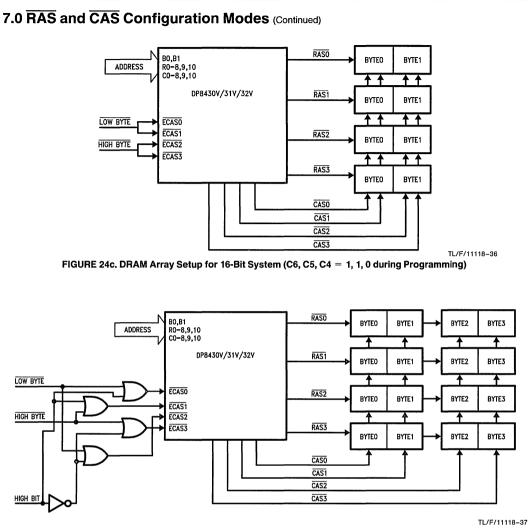


FIGURE 24d. 8 Bank DRAM Array for 16-Bit System (C6, C5, C4 = 1, 1, 0 during Programming)

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## 7.0 RAS and CAS Configuration Modes (Continued)

#### 7.2 MEMORY INTERLEAVING

Memory interleaving allows the cycle time of DRAMs to be reduced by having sequential accesses to different memory banks. Since the DP8430V/31V/32V have separate precharge counters per bank, sequential accesses will not be delayed if the accessed banks use different RAS outputs. To ensure different RAS outputs will be used, a mode is selected where either one or two RAS outputs will be asserted during an access. The bank select or selects, B0 and B1, are then tied to the least significant address bits, causing a different group of RASs to assert during each sequential access as shown in *Figure 25*. In this figure there should be at least one clock period of all RAS's negated between different RAS's being asserted to avoid the condition of a CAS before RAS refresh cycle.

#### 7.3 ADDRESS PIPELINING

Address pipelining allows several access RASs to be asserted at once. Because RASs can overlap, each bank requires either a mode where one RAS and one CAS are used per bank as shown in Figure 26a or where two RASs and two CASs are used per bank as shown in Figure 26b. Byte writing can be accomplished in a 16-bit word system if two RASs and two CASs are used per bank. In other systems, WEs (or external gating on the CAS outputs) must be used to perform byte writing. If WEs are used separate data in and data out buffers must be used. If the array is not layed out this way, a CAS to a bank can be low before RAS, which will cause a refresh of the DRAM, not an access. To take full advantage of address pipelining, memory interleaving is used. To memory interleave, the least significant address bits should be tied to the bank select inputs to ensure that all "back to back" sequential accesses are not delayed, since different memory banks are accessed.

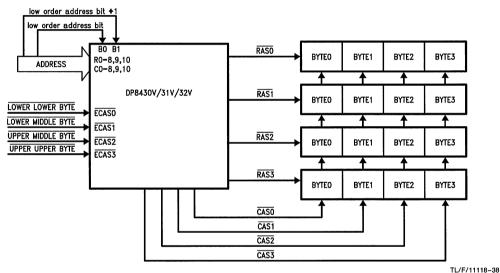
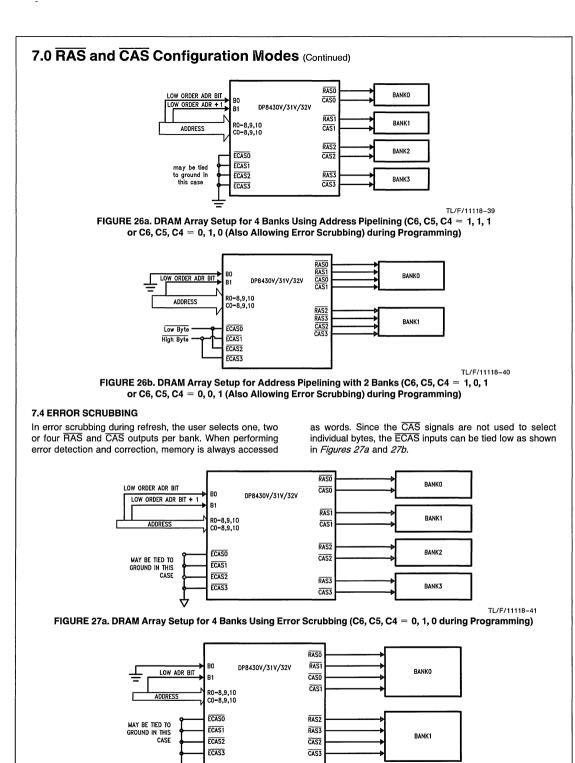


FIGURE 25. Memory Interleaving (C6, C5, C4 = 1, 1, 0 during Programming)



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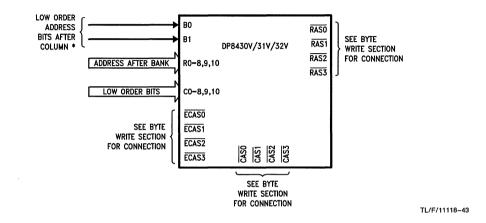
FIGURE 27b. DRAM Array Setup for Error Scrubbing with 2 Banks (C6, C5, C4 = 0, 0, 1 during Programming)

## 7.0 RAS and CAS Configuration Modes (Continued)

#### 7.5 PAGE/BURST MODE

In a static column, page or burst mode system, the least significant bits must be tied to the column address in order to ensure that the page/burst accesses are to sequential memory addresses, as shown in *Figure 28*. In a nibble mode system, the least significant bits must be tied to the highest column and row address bits in order to ensure that sequential address bits are the "nibble" bits for nibble mode accesses (*Figure 28*). The ECAS inputs may then be tog

gled with the DP8430V/31V/32V's address latches in fallthrough mode, while AREQ is asserted. The ECAS inputs can also be used to select individual bytes. When using nibble mode DRAMS, the third and fourth address bits can be tied to the bank select inputs to perform memory interleaving. In page or static column modes, the two address bits after the page size can be tied to the bank select inputs to select a new bank if the page size is exceeded.



\*See table below for row, column & bank address bit map. A0, A1 are used for byte addressing in this example.

| Addresses         | Nibble Mode*              | Page Mode/Static Column Mode Page Size |                           |                         |                |  |
|-------------------|---------------------------|----------------------------------------|---------------------------|-------------------------|----------------|--|
| Auditosto         | NIDDIE MOUE               | 256 Bits/Page                          | 512 Bits/Page             | 1024 Bits/Page          | 2048 Bits/Page |  |
| Column<br>Address | C9,R9 = A2,A3<br>C0-8 = X | C0-7 = A2-9<br>C8-10 = X               | C0-8 = A2-10<br>C9,10 = X | C0-9 = A2-11<br>C10 = X | C0-10 = A2-12  |  |
| Row<br>Address    | x                         | ×                                      | x                         | x                       | х              |  |
| B0<br>B1          | A4<br>A5                  | A10<br>A11                             | A11<br>A12                | A12<br>A13              | A13<br>A14     |  |

Assume that the least significant address bits are used for byte addressing. Given a 32-bit system A0,A1 would be used for byte addressing.

X = DON'T CARE, the user can do as he pleases.

\*Nibble mode values for R and C assume a system using 1 Mbit DRAMs.

FIGURE 28. Page, Static Column, Nibble Mode System

## 8.0 Test Mode

Staggered refresh in combination with the error scrubbing mode places the DP8430V/31V/32V in test mode. In this mode, the 24-bit refresh counter is divided into a 13-bit and 11-bit counter. During refreshes both counters are incremented to reduce test time.

## 9.0 DRAM Critical Timing Parameters

The two critical timing parameters, shown in *Figure 29*, that must be met when controlling the access timing to a DRAM are the row address hold time,  $t_{RAH}$ , and the column address setup time,  $t_{ASC}$ . Since the DP8430V/31V/32V contain a precise internal delay line, the values of these parameters can be selected at programming time. These values will also increase and decrease if DELCLK varies from 2 MHz.

#### 9.1 PROGRAMMABLE VALUES OF tRAH AND TASC

The DP8430V/31V/32V allow the values of  $t_{RAH}$  and  $t_{ASC}$  to be selected at programming time. For each parameter, two choices can be selected.  $t_{RAH}$ , the row address hold time, is measured from RAS asserted to the row address starting to change to the column address. The two choices for  $t_{RAH}$  are 15 ns and 25 ns, programmable through address bit C8.

 $t_{ASC},$  the column address setup time, is measured from the column address valid to  $\overline{CAS}$  asserted. The two choices for  $t_{ASC}$  are 0 ns and 10 ns, programmable through address bit C7.

#### 9.2 CALCULATION OF tRAH AND TASC

There are two clock inputs to the DP8430V/31V/32V. These two clocks, DELCLK and CLK can either be tied together to the same clock or be tied to different clocks running asynchronously at different frequencies.

The clock input, DELCLK, controls the internal delay line and refresh request clock. DELCLK should be a multiple of 2 MHz. If DELCLK is not a multiple of 2 MHz,  $t_{RAH}$  and  $t_{ASC}$  will change. The new values of  $t_{RAH}$  and  $t_{ASC}$  can be calculated by the following formulas:

If  $t_{RAH}$  was programmed to equal 15 ns then  $t_{RAH} = 15^{*}(((DELCLK Divisor)^{*} 2 MHz/(DELCLK Frequency))-1) + 15 ns.$ 

If  $t_{RAH}$  was programmed to equal 25 ns then  $t_{RAH}$  = 25\*(((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency))-1) + 25 ns.

If  $t_{ASC}$  was programmed to equal 0 ns then  $t_{ASC}=12.5^{\ast}$  ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 12.5 ns.

If  $t_{ASC}$  was programmed to equal 10 ns then  $t_{ASC}=22.5^{\ast}$  ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 12.5 ns.

Since the values of  $t_{RAH}$  and  $t_{ASC}$  are increased or decreased, the time to  $\overline{CAS}$  asserted will also increase or decrease. These parameters can be adjusted by the following formula:

Delay to  $\overline{CAS}$  = Actual Spec. + Actual t<sub>RAH</sub> -Programmed t<sub>RAH</sub> + Actual t<sub>ASC</sub> - Programmed t<sub>ASC</sub>.

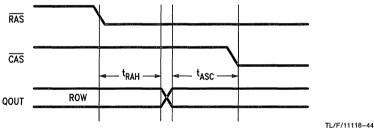


FIGURE 29. t<sub>RAH</sub> and t<sub>ASC</sub>

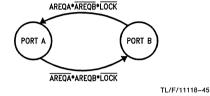
## 10.0 Dual Accessing (DP8432V)

The DP8432V has all the functions previously described. In addition to those features, the DP8432V also has the capabilities to arbitrate among refresh, Port A and a second port, Port B. This allows two CPUs to access a common DRAM array. DRAM refresh has the highest priority followed by the currently granted port. The ungranted port has the lowest priority. The last granted port will continue to stay granted even after the access has terminated, until an access request is received from the ungranted port (see *Figure 30a*). The dual access configuration assumes that both Port A and Port B are synchronous to the system clock. If they are not synchronized (Ex. By running the access requests through several Flip-Flops, see *Figure 32a*).

#### **10.1 PORT B ACCESS MODE**

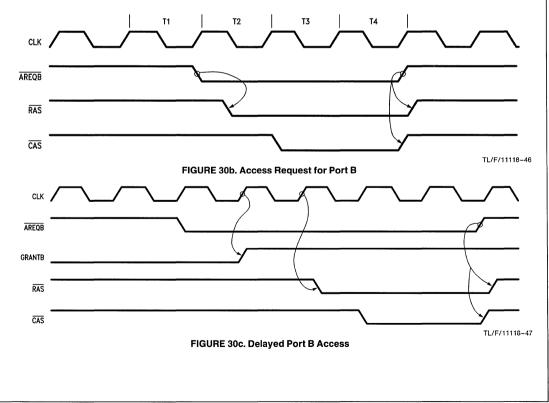
Port B accesses are initiated from a single input,  $\overline{\text{AREQB}}$ . When  $\overline{\text{AREQB}}$  is asserted, an access request is generated. If GRANTB is asserted and a refresh is not taking place or precharge time is not required,  $\overline{\text{RAS}}$  will be asserted when  $\overline{\text{AREQB}}$  is asserted. Once  $\overline{\text{AREQB}}$  is asserted, it must stay asserted until the access is over.  $\overline{\text{AREQB}}$  negated, negates  $\overline{\text{RAS}}$  as shown in *Figure 30b*. Note that if  $\overline{\text{CASO}} = 1$  during programming the  $\overline{\text{CAS}}$  outputs may be held asserted (beyond  $\overline{\text{RAS}}$ n negating) by continuing to assert the appropriate  $\overline{\text{ECAS}}$ n inputs (the same as Port A accesses). If Port B is not granted, the access will begin on the first or second positive edge of CLK after GRANTB is asserted (See R0, R1 programming that Port A is not accessing the DRAM ( $\overline{\text{CS}}$ ,  $\overline{\text{ADS}}'$ , ALE and  $\overline{\text{AREQ}}$ ) and  $\overline{\text{RAS}}$  precharge for the particular bank has completed. It is important to note that for GRANTB to transition to Port B, Port A must **not** be requesting an access at a rising clock edge (or locked) and Port B must be requesting an access at that rising clock edge. Port A can request an access through  $\overline{CS}$  and  $\overline{ADS}/ALE$  or  $\overline{CS}$  and  $\overline{AREQ}$ . Therefore during an interleaved access where  $\overline{CS}$  and  $\overline{ADS}/ALE$  become asserted before  $\overline{AREQ}$  from the previous access is negated, Port A will retain GRANTB = 0 whether  $\overline{AREQB}$  is asserted or not.

Since there is no chip select for Port B, AREQB must incorporate this signal. This mode of accessing is similar to Mode 1 accessing for Port A.





| capitalitation                                 |                                           |  |  |  |
|------------------------------------------------|-------------------------------------------|--|--|--|
| AREQA =                                        | Chip Selected access request from Port A  |  |  |  |
| AREQB =                                        | Chip Selected access request from Port B  |  |  |  |
| LOCK =                                         | Externally controlled LOCKing of the Port |  |  |  |
|                                                | that is currently GRANTed.                |  |  |  |
| FIGURE 30a. DP8432V Port A/Port B Arbitration  |                                           |  |  |  |
| State Diagram. This arbitration may take place |                                           |  |  |  |
|                                                | during the "ACCESS" or "REFRESH"          |  |  |  |
|                                                | state (see <i>Figure 13</i> ).            |  |  |  |



## 10.0 Dual Accessing (DP8432V) (Continued)

#### **10.2 PORT B WAIT STATE SUPPORT**

Advanced transfer acknowledge for Port B,  $\overline{\text{ATACKB}}$ , is used for wait state support for Port B. This output will be asserted when RAS for the Port B access is asserted, as shown in *Figures 31a* and *31b*. Once asserted, this output will stay asserted until  $\overline{\text{AREQB}}$  is negated. With external logic,  $\overline{\text{ATACKB}}$  can be made to interface to any CPU's wait input as shown in *Figure 31c*.

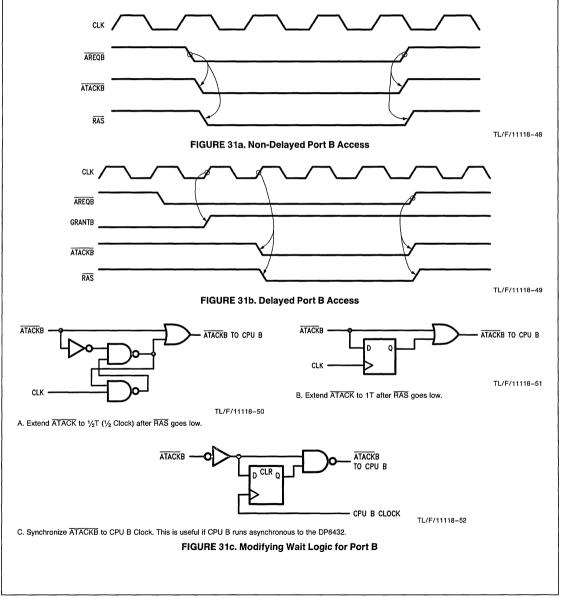
# 10.3 COMMON PORT A AND PORT B DUAL PORT FUNCTIONS

An input, LOCK, and an output, GRANTB, add additional functionality to the dual port arbitration logic. LOCK allows

Port A or Port B to lock out the other port from the DRAM. When a Port is locked out of the DRAM, wait states will be inserted into its access cycle until it is allowed to access memory. GRANTB is used to multiplex the input control signals and addresses to the DP8432V.

#### 10.3.1 GRANTB Output

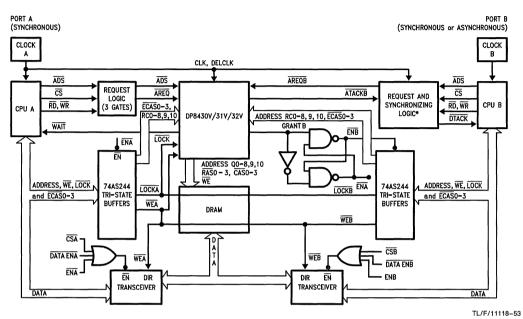
The output GRANTB determines which port has current access to the DRAM array. GRANTB asserted signifies Port B has access. GRANTB negated signifies Port A has access to the DRAM array.



# 10.0 Dual Accessing (DP8432V) (Continued)

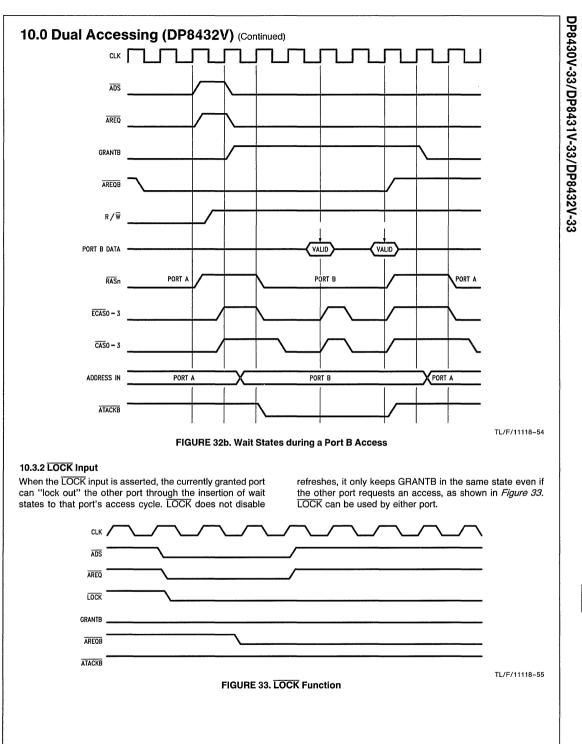
Since the DP8432V has only one set of address inputs, the signal is used, with the addition of buffers, to allow the currently granted port's addresses to reach the DP8432V. The signals which need to be bufferred are R0–10, C0–10, B0–1, ECAS0–3, WE, and LOCK. All other inputs are not common and do not have to be buffered as shown in *Figure 32a*. If a Port, which is not currently granted, tries to access

the DRAM array, the GRANTB output will transition from a rising clock edge from  $\overline{\text{AREQ}}$  or  $\overline{\text{AREQB}}$  negating and will precede the  $\overline{\text{RAS}}$  for the access by one or two clock periods. GRANTB will then stay in this state until the other port requests an access and the currently granted port is not accessing the DRAM as shown in *Figure 32b*.



\*If Port B is synchronous the Request Synchronizing logic will not be required.

## FIGURE 32a. Dual Accessing with the DP8432V (System Block Diagram)



# 11.0 Absolute Maximum Ratings (Note 1)

Storage Temperature .....-65°C to +150°C

All Input or Output Voltage

## **12.0 DC Electrical Characteristics** $T_A = 0^{\circ}C \text{ to } + 70^{\circ}C, V_{CC} = 5V \pm 10\%, GND = 0V$

| Symbol            | Parameter                 | Conditions                                                                      | Min                   | Тур | Max                   | Units |
|-------------------|---------------------------|---------------------------------------------------------------------------------|-----------------------|-----|-----------------------|-------|
| VIH               | Logical 1 Input Voltage   | Tested with a Limited 2.0 Eurotional Pattern                                    |                       |     | V <sub>CC</sub> + 0.5 | v     |
| V <sub>IL</sub>   | Logical 0 Input Voltage   | Tested with a Limited -0.5                                                      |                       |     | 0.8                   | v     |
| V <sub>OH1</sub>  | Q and WE Outputs          | $I_{OH} = -10 \text{ mA}$                                                       | V <sub>CC</sub> - 1.0 |     |                       | ٧     |
| V <sub>OL1</sub>  | Q and WE Outputs          | I <sub>OL</sub> = 10 mA                                                         |                       |     | 0.5                   | V     |
| V <sub>OH2</sub>  | All Outputs except Qs, WE | $I_{OH} = -3 \text{ mA}$                                                        | V <sub>CC</sub> - 1.0 |     |                       | V     |
| V <sub>OL2</sub>  | All Outputs except Qs, WE | $I_{OL} = 3 \text{ mA}$                                                         |                       |     | 0.5                   | ٧     |
| I <sub>IN</sub>   | Input Leakage Current     | $V_{IN} = V_{CC} \text{ or } GND$                                               | -10                   |     | 10                    | μA    |
| IIL ML            | ML Input Current (Low)    | V <sub>IN</sub> = GND                                                           |                       |     | 200                   | μA    |
| ICC1              | Standby Current           | CLK at 8 MHz ( $V_{IN} = V_{CC}$ or GND)                                        |                       | 6   | 15                    | mA    |
| ICC1              | Standby Current           | CLK at 20 MHz ( $V_{IN} = V_{CC}$ or GND)                                       |                       | 8   | 17                    | mA    |
| ICC1              | Standby Current           | CLK at 25 MHz ( $V_{IN} = V_{CC}$ or GND)                                       |                       | 10  | 20                    | mA    |
| I <sub>CC2</sub>  | Supply Current            | CLK at 8 MHz (Inputs Active) $(I_{LOAD} = 0) (V_{IN} = V_{CC} \text{ or GND})$  |                       | 20  | 40                    | mA    |
| I <sub>CC2</sub>  | Supply Current            | CLK at 20 MHz (Inputs Active) $(I_{LOAD} = 0) (V_{IN} = V_{CC} \text{ or GND})$ |                       | 40  | 75                    | mA    |
| I <sub>CC2</sub>  | Supply Current            | CLK at 25 MHz (Inputs Active) ( $I_{LOAD} = 0$ ) ( $V_{IN} = V_{CC}$ or GND)    |                       | 50  | 95                    | mA    |
| C <sub>IN</sub> * | Input Capacitance         | f <sub>IN</sub> at 1 MHz                                                        |                       |     | 10                    | pF    |

\*CIN is not 100% tested.

# 13.0 AC Timing Parameters

Two speed selections are given, the DP8430V/31V/32V-20 and the DP8430V/31V/32V-33. The differences between the two parts are the maximum operating frequencies of the input CLKs and the maximum delay specifications. Low frequency applications may use the "-25" part to gain improved timing.

The AC timing parameters are grouped into sectional numbers as shown below. These numbers also refer to the timing diagrams.

1-36 Common parameters to all modes of operation

50-56 Difference parameters used to calculate; RAS low time,

RAS precharge time, CAS high time and CAS low time

- 100-121 Common dual access parameters used for Port B accesses and inputs and outputs used only in dual accessing
- 200-212 Refresh parameters

- 300-315 Mode 0 access parameters used in both single and dual access applications
- 400-416 Mode 1 access parameters used in both single and dual access applications
- 450-455 Special Mode 1 access parameters which supersede the 400-416 parameters when dual accessing
- 500-506 Programming parameters

Unless otherwise stated  $V_{CC}=5.0V~\pm10\%,~0< T_A<70^\circ C,$  the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except
- $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or
- $C_H = 50 \text{ pF}$  loads on all outputs except
- $C_{H} = 125 \text{ pF}$  loads on  $\overline{RAS0}-3$  and  $\overline{CAS0}-3$  and
- $C_{H} = 380 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ .

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation. Note 2: Input pulse 0V to 3V; tR = tF = 2.5 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.4V for High and 0.8V for Low.

Note 2: Input pulse 0V to 3V; H = tF = 2.5 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.4V for High and 0.8V for Low. Note 3: AC Production testing is done at 50 pF.

DELCLK  $\xrightarrow{7}$ 

FIGURE 36. Clock, DELCLK Timing

TL/F/11118-56

**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and WE; or
- $C_H=50~pF$  loads on all outputs except  $C_H=125~pF$  loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380~pF$  loads on Q0–8, 9, 10 and  $\overline{WE}.$

|        |                                                                                                       | Common Parameter                                                                                      |     | DP8430V/31V/32V-33 |     |          |
|--------|-------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|-----|--------------------|-----|----------|
| Number | Symbol                                                                                                | Description                                                                                           |     | CL                 | 0   | <u>н</u> |
|        |                                                                                                       |                                                                                                       | Min | Max                | Min | Max      |
| 1      | fclk                                                                                                  | CLK Frequency                                                                                         | 0   | 33                 | 0   | 33       |
| 2      | tCLKP                                                                                                 | CLK Period                                                                                            | 30  |                    | 30  |          |
| 3, 4   | tCLKPW                                                                                                | CLK Pulse Width                                                                                       | 12  |                    | 12  |          |
| 5      | fDCLK                                                                                                 | DELCLK Frequency                                                                                      | 12  | 40                 | 12  | 40       |
| 6      | tDCLKP                                                                                                | DELCLK Period                                                                                         | 25  | 83                 | 25  | 83       |
| 7, 8   | tDCLKPW                                                                                               | DELCLK Pulse Width                                                                                    | 12  |                    | 12  |          |
| 9a     | tPRASCAS0                                                                                             | $\overline{\text{RAS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)   | 30  |                    | 30  |          |
| 9b     | tPRASCAS1                                                                                             | $\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)                | 40  |                    | 40  |          |
| 9c     | tPRASCAS2                                                                                             | ( $\overline{\text{RAS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns) | 40  |                    | 40  |          |
| 9d     | tPRASCAS3                                                                                             | ( $\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)              | 50  |                    | 50  |          |
| 10a    | tRAH                                                                                                  | Row Address Hold Time (tRAH = 15)                                                                     | 15  |                    | 15  |          |
| 10b    | tRAH                                                                                                  | Row Address Hold Time (tRAH = 25)                                                                     | 25  |                    | 25  |          |
| 11a    | tASC                                                                                                  | Column Address Setup Time (tASC = 0)                                                                  | 0   |                    | 0   |          |
| 11b    | tASC                                                                                                  | Column Address Setup Time (tASC = 10)                                                                 | 10  |                    | 10  |          |
| 12     | tPCKRAS                                                                                               | CLK High to RAS Asserted<br>following Precharge                                                       |     | 16                 |     | 20       |
| 13     | tPARQRAS                                                                                              | AREQ Negated to RAS Negated                                                                           |     | 21                 |     | 25       |
| 14     | tPENCL                                                                                                | ECAS0-3 Asserted to CAS Asserted                                                                      |     | 15                 |     | 22       |
| 15     | tPENCH                                                                                                | ECAS0-3 Negated to CAS Negated                                                                        |     | 16                 |     | 23       |
| 16     | tPARQCAS                                                                                              | AREQ Negated to CAS Negated                                                                           |     | 37                 |     | 44       |
| 17     | tPCLKWH                                                                                               | CLK to WAIT Negated                                                                                   |     | 23                 |     | 23       |
| 18     | tPCLKDL0                                                                                              | CLK to DTACK Asserted<br>(Programmed as DTACK of 1/2, 1, 1½<br>or if WAITIN is Asserted)              | 23  |                    |     | 23       |
| 19     | tPEWL                                                                                                 | ECAS Negated to WAIT Asserted<br>during a Burst Access                                                | 28  |                    | 28  |          |
| 20     | tSECK ECAS Asserted Setup to CLK High to<br>Recognize the Rising Edge of CLK<br>during a Burst Access |                                                                                                       | 13  |                    | 13  |          |

**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A$  < 70°C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{WE}$ ; or

- $C_{H}=50$  pF loads on all outputs except  $C_{H}=125$  pF loads on  $\overline{RAS0}{-}3$  and  $\overline{CAS0}{-}3$  and  $C_{H}=380$  pF loads on Q0–8, 9, 10 and  $\overline{WE}.$

|        |          | Common Parameter                                                                          |       | DP8430V/3 | 1V/32V-33 |     |  |
|--------|----------|-------------------------------------------------------------------------------------------|-------|-----------|-----------|-----|--|
| Number | Symbol   | Description                                                                               |       | CL        | (         | н   |  |
|        |          |                                                                                           | Min   | Max       | Min       | Max |  |
| 21     | tPEDL    | ECAS Asserted to DTACK<br>Asserted during a Burst Access<br>(Programmed as DTACK0)        |       | 28        |           | 28  |  |
| 22     | tPEDH    | ECAS Negated to DTACK<br>Negated during a Burst Access                                    |       | 30        |           | 30  |  |
| 23     | tSWCK    | WAITIN Asserted Setup to CLK                                                              | 4     |           | 4         |     |  |
| 24     | tPWINWEH | WIN Asserted to WE Asserted                                                               |       | 23        |           | 33  |  |
| 25     | tPWINWEL | WIN Negated to WE Negated                                                                 |       | 23        |           | 33  |  |
| 26     | tPAQ     | Row, Column Address Valid to<br>Q0–8, 9, 10 Valid                                         |       | 21        |           | 30  |  |
| 27     | tPCINCQ  | COLINC Asserted to Q0-8, 9, 10<br>Incremented                                             | 24    |           |           | 33  |  |
| 28     | tSCINEN  | COLINC Asserted Setup to $\overline{\text{ECAS}}$<br>Asserted to Ensure tASC = 0 ns       | 13    |           | 15        |     |  |
| 29a    | tSARQCK1 | AREQ, AREQB Negated Setup to CLK<br>High with 1 Period of Precharge                       | 29    |           | 29        |     |  |
| 29b    | tSARQCK2 | AREQ, AREQB Negated Setup to CLK High<br>with >1 Period of Precharge Programmed           | 10    |           | 10        |     |  |
| 30     | tPAREQDH | AREQ Negated to DTACK Negated                                                             | 20    |           |           | 20  |  |
| 31     | tPCKCAS  | CLK High to CAS Asserted when Delayed by WIN                                              |       | 15        |           | 22  |  |
| 32     | tSCADEN  | Column Address Setup to $\overline{\text{ECAS}}$<br>Asserted to Guarantee tASC = 0        | 7     |           | 8         |     |  |
| 33     | tWCINC   | COLINC Pulse Width                                                                        | 10    |           | 10        |     |  |
| 34a    | tPCKCL0  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 15 ns, tASC = 0 ns)  |       | 65        |           | 73  |  |
| 34b    | tPCKCL1  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 15 ns, tASC = 10 ns) |       | 75        |           | 83  |  |
| 34c    | tPCKCL2  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 0 ns)  | 75    |           |           | 83  |  |
| 34d    | tPCKCL3  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 10 ns) | 85    |           |           | 93  |  |
| 35     | tCAH     | Column Address Hold Time<br>(Interleave Mode Only)                                        | 25 25 |           |           |     |  |
| 36     | tPCQR    | CAS Asserted to Row Address<br>Valid (Interleave Mode Only)                               |       | 70        |           | 70  |  |

**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and WE; or

 $C_H=50~\text{pF}$  loads on all outputs except  $C_H=125~\text{pF}$  loads on RAS0–3 and CAS0–3 and  $C_H=380~\text{pF}$  loads on Q0–8, 9, 10 and WE.

|        |        |                                                                                   | DP8430V/31V/32 |     | 31V/32V-33     | -33 |  |
|--------|--------|-----------------------------------------------------------------------------------|----------------|-----|----------------|-----|--|
| Number | Symbol | Difference<br>Parameter Description                                               |                | CL  | C <sub>H</sub> |     |  |
|        |        |                                                                                   | Min            | Max | Min            | Max |  |
| 50     | tD1    | (AREQ or AREQB Negated to RAS<br>Negated) Minus (CLK High to RAS<br>Asserted)     | 9              |     | 9              |     |  |
| 51     | tD2    | (CLK High to Refresh RAS Negated)<br>Minus (CLK High to RAS Asserted)             | 7              |     | 7              |     |  |
| 52     | tD3a   | (ADS Asserted to RAS Asserted<br>(Mode 1)) Minus (AREQ Negated<br>to RAS Negated) |                | 2   |                | 2   |  |
| 53     | tD3b   | (CLK High to RAS Asserted (Mode 0))<br>Minus (AREQ Negated to RAS Negated)        |                | 2   |                | 2   |  |
| 54     | tD4    | (ECAS Asserted to CAS Asserted)<br>Minus (ECAS Negated to CAS Negated)            | -4 4 -         |     | -4             | 4   |  |
| 55     | tD5    | (CLK to Refresh RAS Asserted) Minus (CLK to Refresh RAS Negated)                  | 2              |     | 2              |     |  |
| 56     | tD6    | (AREQ Negated to RAS Negated)<br>Minus (ADS Asserted to RAS<br>Asserted (Mode 1)) | 4              |     | 4              |     |  |

# DP8430V-33/DP8431V-33/DP8432V-33

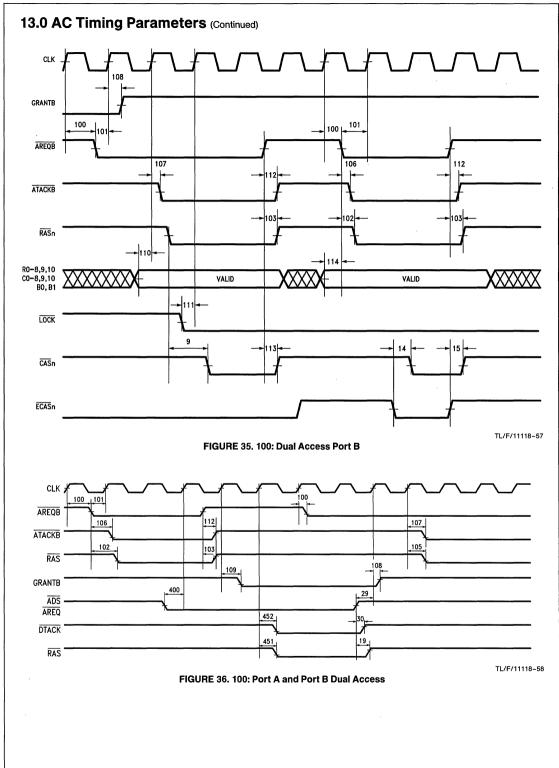
**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{\text{WE}}$ ; or

 $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0–3 and CAS0–3 and  $C_H=380$  pF loads on Q0–8, 9, 10 and WE.

| Number | Symbol           | Common Dual Access                                                                                              |     | CL   | 31V/32V-33 | с <sub>н</sub> |  |
|--------|------------------|-----------------------------------------------------------------------------------------------------------------|-----|------|------------|----------------|--|
| number | Symbol           | Parameter Description                                                                                           | Min | Max  | Min        | Мах            |  |
| 100    | tHCKARQB         | AREQB Negated Held from CLK High                                                                                | 2   | Indx | 2          | max            |  |
| 101    | tSARQBCK         | AREQB Asserted Setup to CLK High                                                                                | 4   |      | 4          |                |  |
| 102    | tPAQBRASL        | AREQB Asserted to RAS Asserted                                                                                  |     | 28   |            | 32             |  |
| 103    | tPAQBRASH        | AREQB Negated to RAS Negated                                                                                    |     | 25   |            | 30             |  |
| 105    | tPCKRASG         | CLK High to RAS Asserted for<br>Pending Port B Access                                                           |     | 35   |            | 40             |  |
| 106    | tPAQBATKBL       | AREQB Asserted to ATACKB Asserted                                                                               |     | 33   |            | 33             |  |
| 107    | tPCKATKB         | CLK High to ATACKB Asserted<br>for Pending Access                                                               |     | 40   |            | 40             |  |
| 108    | tPCKGH           | CLK High to GRANTB Asserted                                                                                     |     | 26   |            | 26             |  |
| 109    | tPCKGL           | CLK High to GRANTB Negated                                                                                      |     | 20   |            | 20             |  |
| 110    | tSADDCKG         | Row Address Setup to CLK High That<br>Asserts RAS following a GRANTB<br>Change to Ensure tASR = 0 ns for Port B | 7   |      | 11         |                |  |
| 111    | tSLOCKCK         | LOCK Asserted Setup to CLK Low<br>to Lock Current Port                                                          | 2   |      | 2          |                |  |
| 112    | <b>tPAQATKBH</b> | AREQ Negated to ATACKB Negated                                                                                  | 10  |      |            | 10             |  |
| 113    | tPAQBCASH        | AREQB Negated to CAS Negated                                                                                    | 35  |      |            | 42             |  |
| 114    | tSADAQB          | Address Valid Setup to<br>AREQB Asserted                                                                        | 3   |      | 7          |                |  |
| 116    | tHCKARQG         | AREQ Negated Held from CLK High                                                                                 | 3   |      | 3          |                |  |
| 117    | tWAQB            | $\overline{AREQB}$ High Pulse Width<br>to Guarantee tASR = 0 ns                                                 | 15  |      | 17         |                |  |
| 118a   | tPAQBCAS0        | $\overline{AREQB}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)                         |     | 80   |            | 87             |  |
| 118b   | tPAQBCAS1        | $\overline{AREQB}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)                        |     | 90   |            | 97             |  |
| 118c   | tPAQBCAS2        | $\overline{AREQB}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)                         |     | 90   |            | 97             |  |
| 118d   | tPAQBCAS3        | $\overline{AREQB}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)                        |     | 100  |            | 107            |  |
| 120a   | tPCKCASG0        | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 15 ns, tASC = 0 ns)               |     | 80   |            | 87             |  |
| 120b   | tPCKCASG1        | CLK High to CAS Asserted<br>for Pending Port B Access<br>(tRAH = 15 ns, tASC = 10 ns)                           | 90  |      |            | 97             |  |
| 120c   | tPCKCASG2        | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 25 ns, tASC = 0 ns)               | 90  |      | 97         |                |  |
| 120d   | tPCKCASG3        | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 25 ns, tASC = 10 ns)              | 100 |      | 107        |                |  |
| 121    | tSBADDCKG        | Bank Address Valid Setup to CLK<br>High That Starts RAS<br>for Pending Port B Access                            | 5   |      | 5          |                |  |



1-250

# DP8430V-33/DP8431V-33/DP8432V-33

**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A$  < 70°C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

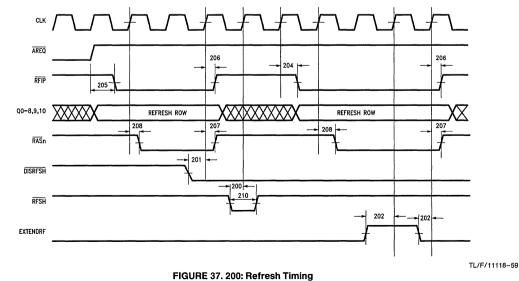
Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_L = 150 \text{ pF}$  loads on Q0–8, 9, 10 and WE; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380$  pF loads on Q0-8, 9, 10 and  $\overline{WE}.$

|        |            |                                                                                                                           | DP8430V/31V/32V-33 |     |                |     |  |
|--------|------------|---------------------------------------------------------------------------------------------------------------------------|--------------------|-----|----------------|-----|--|
| Number | Symbol     | Refresh Parameter<br>Description                                                                                          |                    | CL  | C <sub>H</sub> |     |  |
|        |            | Description                                                                                                               | Min                | Max | Min            | Max |  |
| 200    | tSRFCK     | RFSH Asserted Setup to CLK High                                                                                           | 16                 |     | 16             |     |  |
| 201    | tSDRFCK    | DISRFSH Asserted Setup to CLK High                                                                                        | 16                 |     | 16             |     |  |
| 202    | tSXRFCK    | EXTENDRF Setup to CLK High                                                                                                | 8                  |     | 8              |     |  |
| 204    | tPCKRFL    | CLK High to RFIP Asserted                                                                                                 |                    | 25  |                | 25  |  |
| 205    | tPARQRF    | AREQ Negated to RFIP Asserted                                                                                             |                    | 35  |                | 35  |  |
| 206    | tPCKRFH    | CLK High to RFIP Negated                                                                                                  |                    | 37  |                | 37  |  |
| 207    | tPCKRFRASH | CLK High to Refresh RAS Negated                                                                                           | 23                 |     | 27             |     |  |
| 208    | tPCKRFRASL | CLK High to Refresh RAS Asserted                                                                                          | 19                 |     |                | 19  |  |
| 209a   | tPCKCL0    | CLK High to $\overline{CAS}$ Asserted<br>during Error Scrubbing<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)    | 64                 |     |                | 73  |  |
| 209b   | tPCKCL1    | CLK High to $\overline{CAS}$ Asserted<br>during Error Scrubbing<br>( $t_{RAH} = 15 \text{ ns}, t_{ASC} = 10 \text{ ns}$ ) | 74                 |     | 83             |     |  |
| 209c   | tPCKCL2    | CLK High to $\overline{CAS}$ Asserted<br>during Error Scrubbing<br>(t <sub>RAH</sub> = 25 ns, t <sub>ASC</sub> = 0 ns)    | 74                 |     | 83             |     |  |
| 209d   | tPCKCL3    | CLK High to $\overline{CAS}$ Asserted<br>during Error Scrubbing<br>( $t_{RAH} = 25 \text{ ns}, t_{ASC} = 10 \text{ ns}$ ) | 85                 |     | 94             |     |  |
| 210    | tWRFSH     | RFSH Pulse Width                                                                                                          | 9                  |     | 9              |     |  |
| 211    | tPCKRQL    | CLK High to RFRQ Asserted                                                                                                 |                    | 22  |                | 22  |  |
| 212    | tPCKRQH    | CLK High to RFRQ Negated                                                                                                  |                    | 22  |                | 22  |  |



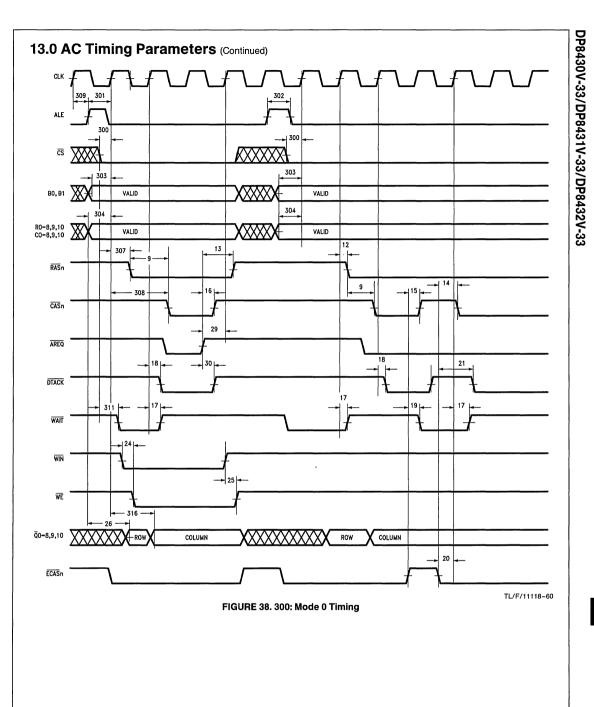
**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{\text{WE}}$ ; or

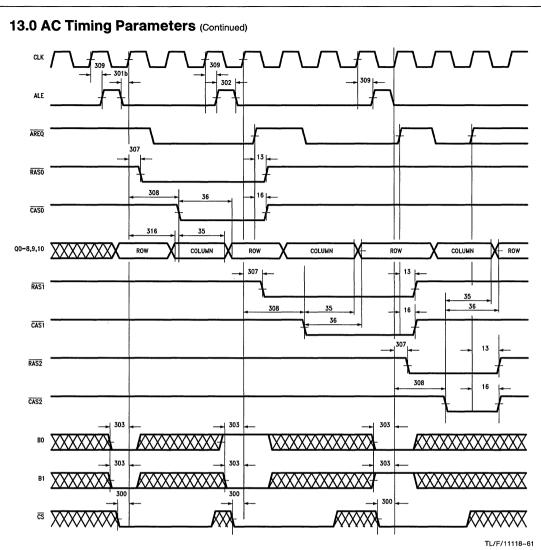
- $C_H=50~pF$  loads on all outputs except  $C_H=125~pF$  loads on RAS0-3 and CAS0-3 and  $C_H=380~pF$  loads on Q0-8, 9, 10 and  $\overline{WE}.$

| Number | Gumbal                                                                                                                                         | Mode 0 Access                                                                                                                       |     |     | 31V/32V-33<br>Сн |          |  |
|--------|------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------------------|----------|--|
| Number | Symbol                                                                                                                                         | Parameter Description                                                                                                               | Min | Max | Min              | H<br>Max |  |
| 300    | tSCSCK                                                                                                                                         | CS Asserted to CLK High                                                                                                             | 8   | max | 8                | wax      |  |
| 301a   | tSALECKNL                                                                                                                                      | ALE Asserted Setup to CLK High<br>Not Using On-Chip Latches or<br>if Using On-Chip Latches and<br>B0, B1, Are Constant, Only 1 Bank | 10  |     | 10               |          |  |
| 301b   | tSALECKL                                                                                                                                       | ALE Asserted Setup to CLK High,<br>if Using On-Chip Latches if B0, B1<br>Can Change, More Than One Bank                             | 18  |     | 18               |          |  |
| 302    | tWALE                                                                                                                                          | ALE Pulse Width                                                                                                                     | 15  |     | 15               |          |  |
| 303    | tSBADDCK                                                                                                                                       | Bank Address Valid Setup to CLK High                                                                                                | 10  |     | 10               |          |  |
| 304    | tSADDCK                                                                                                                                        | Row, Column Valid Setup to<br>CLK High to Guarantee<br>tASR = 0 ns                                                                  | 4   |     | 8                |          |  |
| 305    | tHASRCB                                                                                                                                        | Row, Column, Bank Address<br>Held from ALE Negated<br>(Using On-Chip Latches)                                                       | 6   |     | 6                |          |  |
| 306    | tSRCBAS Row, Column, Bank Address<br>Setup to ALE Negated 1<br>(Using On-Chip Latches)                                                         |                                                                                                                                     |     | 1   |                  |          |  |
| 307    | tPCKRL                                                                                                                                         | CLK High to RAS Asserted                                                                                                            |     | 20  |                  | 25       |  |
| 308a   | tPCKCL0                                                                                                                                        | L0 CLK High to CAS Asserted<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)                                                  |     | 63  |                  | 70       |  |
| 308b   | tPCKCL1                                                                                                                                        | CLK High to CAS         Asserted         74           (t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 10 ns)         74               |     | 74  |                  | 81       |  |
| 308c   | tPCKCL2                                                                                                                                        | CLK High to $\overline{CAS}$ Asserted<br>(t <sub>RAH</sub> = 25 ns, t <sub>ASC</sub> = 0 ns)                                        |     | 74  |                  | 81       |  |
| 308d   | tPCKCL3                                                                                                                                        | CLK High to CAS Asserted<br>(t <sub>RAH</sub> = 25 ns, t <sub>ASC</sub> = 10 ns)                                                    |     | 88  |                  | 95       |  |
| 309    | tHCKALE                                                                                                                                        | ALE Negated Hold from CLK High                                                                                                      | 0   |     | 0                |          |  |
| 310    | tSWINCK                                                                                                                                        | WIN Asserted Setup to CLK High to Guarantee CAS is Delayed                                                                          | -16 |     | - 16             |          |  |
| 311    | tPCSWL                                                                                                                                         | CS Asserted to WAIT Asserted                                                                                                        |     | 16  |                  | 16       |  |
| 312    | tPCSWH                                                                                                                                         | CS Negated to WAIT Negated                                                                                                          |     | 18  |                  | 18       |  |
| 313    | tPCLKDL1                                                                                                                                       | CLK High to DTACK Asserted<br>(Programmed as DTACK0)                                                                                |     | 25  |                  | 25       |  |
| 314    | tPALEWL                                                                                                                                        | ALE Asserted to WAIT Asserted<br>(CS is Already Asserted)                                                                           |     | 20  |                  | 20       |  |
| 315    | AREQ Negated to CLK High That Starts           Access RAS to Guarantee tASR = 0 ns         25           (Non-Interleaved Mode Only)         25 |                                                                                                                                     |     | 29  |                  |          |  |
| 316    | tPCKCV0                                                                                                                                        | CLK High to Column<br>Address Valid<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)                                          |     | 55  |                  | 60       |  |
| 317    | tPCKCV1                                                                                                                                        | CLK High to Column<br>Address Valid<br>(t <sub>RAH</sub> = 25 ns, t <sub>ASC</sub> = 0 ns)                                          |     | 65  |                  | 65       |  |



----

1



(Programmed as C4 = 1, C5 = 1, C6 = 1)



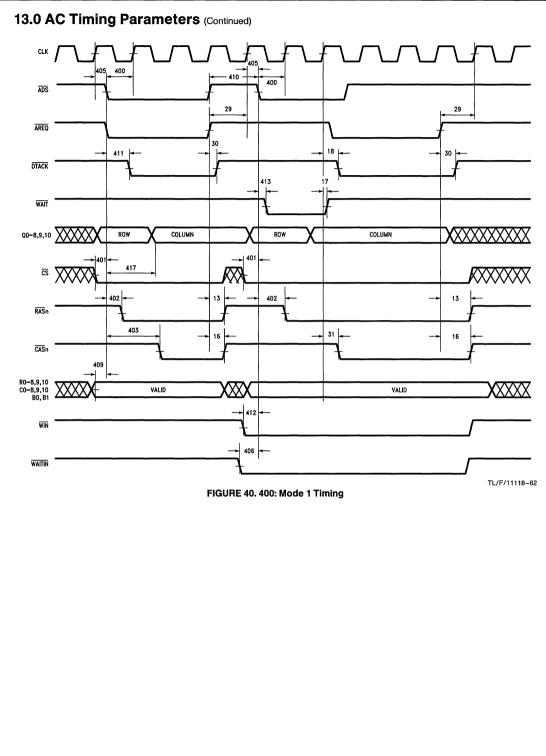
**13.0 AC Timing Parameters** (Continued) Unless otherwise stated V<sub>CC</sub> =  $5.0V \pm 10\%$ , 0°C < T<sub>A</sub> < 70°C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

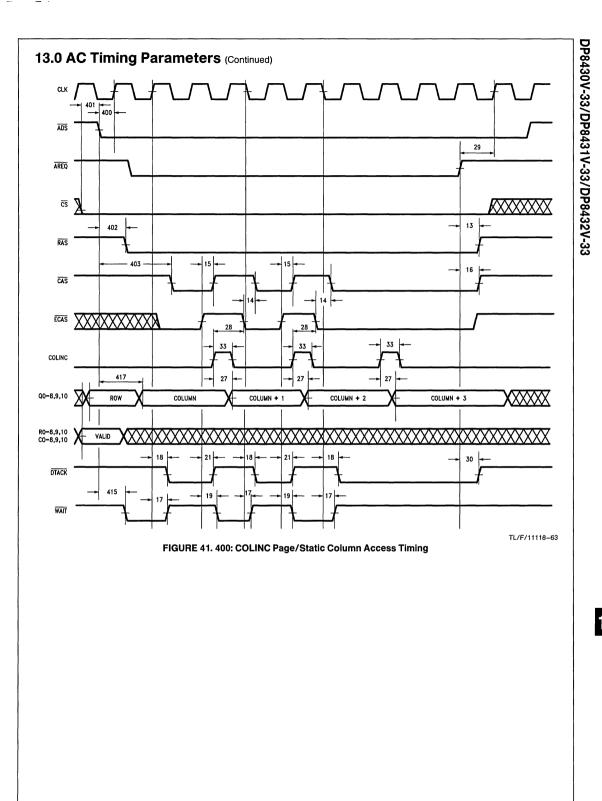
 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and  $\overline{\text{WE}}$ ; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380$  pF loads on Q0-8, 9, 10 and  $\overline{WE}.$

|        |          | Mode 1 Access                                                                                                     |                                   |            | 31V/32V-33 |          |
|--------|----------|-------------------------------------------------------------------------------------------------------------------|-----------------------------------|------------|------------|----------|
| Number | Symbol   | Parameter Description                                                                                             |                                   | <u>ک</u> ل |            | <u>н</u> |
|        |          |                                                                                                                   | Min Max                           |            | Min        | Max      |
| 400a   | tSADSCK1 | ADS Asserted Setup to CLK High                                                                                    | 8                                 |            | 8          |          |
| 400b   | tSADSCKW | ADS Asserted Setup to CLK<br>(to Guarantee Correct WAIT<br>or DTACK Output; Doesn't Apply for DTACK0)             | 19                                |            | 19         |          |
| 401    | tSCSADS  | CS Setup to ADS Asserted                                                                                          | 2                                 |            | 2          |          |
| 402    | tPADSRL  | ADS Asserted to RAS Asserted                                                                                      |                                   | 21         |            | 25       |
| 403a   | tPADSCL0 | $\overline{ADS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)                             |                                   | 68         |            | 75       |
| 403b   | tPADSCL1 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)              |                                   | 78         |            | 85       |
| 403c   | tPADSCL2 | $\overline{ADS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)                             |                                   | 78         |            | 85       |
| 403d   | tPADSCL3 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)              |                                   | 88         |            | 95       |
| 404    | tSADDADS | Row Address Valid Setup to ADS<br>Asserted to Guarantee tASR = 0 ns                                               | 3                                 |            | 5          |          |
| 405    | tHCKADS  | ADS Negated Held from CLK High                                                                                    | 0                                 |            | 0          |          |
| 406    | tSWADS   | WAITIN Asserted Setup to ADS<br>Asserted to Guarantee DTACK0<br>Is Delayed                                        | 0                                 |            | 0          |          |
| 407    | tSBADAS  | Bank Address Setup to ADS Asserted                                                                                | k Address Setup to ADS Asserted 6 |            | 6          |          |
| 408    | tHASRCB  | Row, Column, Bank Address Held from<br>ADS Asserted (Using On-Chip Latches)                                       | 6                                 |            | 6          |          |
| 409    | tSRCBAS  | Row, Column, Bank Address Setup to<br>ADS Asserted (Using On-Chip Latches)                                        | 1                                 |            | 1          |          |
| 410    | tWADSH   | ADS Negated Pulse Width                                                                                           | 12                                |            | 17         |          |
| 411    | tPADSD   | ADS Asserted to DTACK Asserted<br>(Programmed as DTACK0)                                                          |                                   | 28         |            | 28       |
| 412    | tSWINADS | WIN Asserted Setup to ADS Asserted<br>(to Guarantee CAS Delayed during<br>Writes Accesses)                        | -10                               |            | -10        |          |
| 413    | tPADSWL0 | ADS Asserted to WAIT Asserted<br>(Programmed as WAIT0, Delayed Access)                                            |                                   | 20         |            | 20       |
| 414    | tPADSWL1 | ADS Asserted to WAIT Asserted<br>(Programmed WAIT 1/2 or 1)                                                       |                                   | 20         |            | 20       |
| 415    | tPCLKDL1 | CLK High to DTACK Asserted<br>(Programmed as DTACK0,<br>Delayed Access)                                           | 25                                |            | 25         |          |
| 416    |          | $\overline{AREQ}$ Negated to $\overline{ADS}$ Asserted<br>to Guarantee tASR = 0 ns<br>(Non Interleaved Mode Only) | 18 20                             |            |            |          |
| 417    | tPADSCV0 | ADS Asserted to Column<br>Address Valid<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)                    |                                   | 51         |            | 60       |



DP8430V-33/DP8431V-33/DP8432V-33



**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9, 10 and WE; or

 $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380$  pF loads on Q0–8, 9, 10 and  $\overline{WE}.$ 

|        |           |                                                                                                                       | DP8430V/31V/32V-33 |     |     |     |  |
|--------|-----------|-----------------------------------------------------------------------------------------------------------------------|--------------------|-----|-----|-----|--|
| Number | Symbol    | Mode 1 Dual Access Parameter Description                                                                              |                    | CL  | C   | Эн  |  |
|        |           |                                                                                                                       | Min                | Max | Min | Max |  |
| 450    | tSADDCKG  | Row Address Setup to CLK High That<br>Asserts RAS following a GRANTB<br>Port Change to Ensure tASR = 0 ns             | 7                  |     | 11  |     |  |
| 451    | tPCKRASG  | CLK High to RAS Asserted<br>for Pending Access                                                                        |                    | 30  |     | 35  |  |
| 452    | tPCLKDL2  | CLK to DTACK Asserted for Delayed<br>Accesses (Programmed as DTACK0)                                                  | 33                 |     |     | 33  |  |
| 453a   | tPCKCASG0 | CLK High to $\overline{CAS}$ Asserted<br>for Pending Access<br>(t <sub>RAH</sub> = 15 ns, t <sub>ASC</sub> = 0 ns)    | 81                 |     |     | 89  |  |
| 453b   | tPCKCASG1 | CLK High to $\overline{CAS}$ Asserted<br>for Pending Access<br>( $t_{RAH} = 15 \text{ ns}, t_{ASC} = 10 \text{ ns}$ ) | 91                 |     |     | 99  |  |
| 453c   | tPCKCASG2 | CLK High to $\overline{CAS}$ Asserted<br>for Pending Access<br>(t <sub>RAH</sub> = 25 ns, t <sub>ASC</sub> = 0 ns)    | 91                 |     |     | 99  |  |
| 453d   | tPCKCASG3 | CLK High to $\overline{CAS}$ Asserted<br>for Pending Access<br>(t <sub>RAH</sub> = 25 ns, t <sub>ASC</sub> = 10 ns)   | 101                |     |     | 109 |  |
| 454    | tSBADDCKG | Bank Address Valid Setup to CLK High that Asserts $\overline{\text{RAS}}$ for Pending Access                          | 3 3                |     | 3   |     |  |
| 455    | tSADSCK0  | ADS Asserted Setup to CLK High                                                                                        | 8                  |     | 8   |     |  |

**13.0 AC Timing Parameters** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (Note 2).

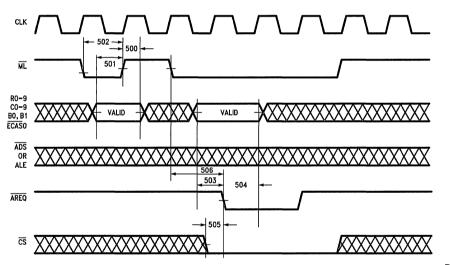
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 $C_L = 50 \text{ pF}$  loads on all outputs except

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 $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380$  pF loads on Q0-8, 9, 10 and  $\overline{WE}.$ 

|        |          |                                          | DP8430V/31V/32V-33 |     |     |     |  |
|--------|----------|------------------------------------------|--------------------|-----|-----|-----|--|
| Number | Symbol   | Symbol Programming Parameter Description |                    | CL  |     | н   |  |
|        |          |                                          | Min                | Max | Min | Max |  |
| 500    | tHMLADD  | Mode Address Held from ML Negated        | 4                  |     | 4   |     |  |
| 501    | tSADDML  | Mode Address Setup to ML Negated         | 3                  |     | 3   |     |  |
| 502    | tWML     | ML Pulse Width                           | 9                  |     | 9   |     |  |
| 503    | tSADAQML | Mode Address Setup to AREQ Asserted      | 0                  |     | 0   |     |  |
| 504    | tHADAQML | Mode Address Held from AREQ Asserted     | 30                 |     | 30  |     |  |
| 505    | tSCSARQ  | CS Asserted Setup to<br>AREQ Asserted    | 3                  |     | 3   |     |  |
| 506    | tSMLARQ  | ML Asserted Setup to AREQ Asserted       | 6 6                |     |     |     |  |



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FIGURE 42. 500: Programming

# 14.0 DP8430V/31V/32V User Hints

1. All inputs to the DP8430V/31V/32V should be tied high, low or the output of some other device.

Note: One signal is active high. COLINC (EXTNDRF) should be tied low to disable.

- 2. Each ground on the DP8430V/31V/32V must be decoupled to the closest on-chip supply ( $V_{CC}$ ) with 0.1  $\mu$ F ceramic capacitor. This is necessary because these grounds are kept separate inside the DP8430V/31V/32V. The decoupling capacitors should be placed as close as possible with short leads to the ground and supply pins of the DP8430V/31V/32V.
- 3. The output called "CAP" should have a 0.1  $\mu\text{F}$  capacitor to ground.
- 4. The DP8430V/31V/32V has  $20\Omega$  series damping resistors built into the output drivers of RAS, CAS, address and WE/RFRQ. Space should be provided for external damping resistors on the printed circuit board (or wirewrap board) because they may be needed. The value of these damping resistors (if needed) will vary depending upon the output, the capacitance of the load, and the characteristics of the trace as well as the routing of the trace. The value of the damping resistor also may vary between the wire-wrap board and the printed circuit board. To determine the value of the series damping resistor it is recommended to use an oscilloscope and look at the furthest DRAM from the DP8430V/31V/32V. The undershoot of RAS, CAS, WE and the addresses should be kept to less than 0.5V below ground by varying the value of the damping resistor. The damping resistors should be placed as close as possible with short leads to the driver outputs of the DP8430V/31V/32V.
- 5. The circuit board must have a good V<sub>CC</sub> and ground plane connection. If the board is wire-wrapped, the V<sub>CC</sub> and ground pins of the DP8430V/31V/32V, the DRAM associated logic and buffer circuitry must be soldered to the V<sub>CC</sub> and ground planes.

- 6. The traces from the DP8430V/31V/32V to the DRAM should be as short as possible.
- 7. Parameter Changes due to Loading

All A.C. parameters are specified with the equivalent load capacitances, including traces, of 64 DRAMs organized as 4 banks of 18 DRAMs each. Maximums are based on worst-case conditions. If an output load changes then the A.C. timing parameters associated with that particular output must be changed. For example, if we changed our output load to

C = 250 pF loads on  $\overline{RAS0}-3$  and  $\overline{CAS0}-3$ 

C = 760 pF loads on Q0-9 and  $\overline{WE}$ 

we would have to modify some parameters (not all calculated here)

\$308a clock to CAS asserted

 $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns})$ 

A ratio can be used to figure out the timing change per change in capacitance for a particular parameter by using the specifications and capacitances from heavy and light load timing.

 $\begin{aligned} \text{Ratio} &= \frac{\$308 \text{ a w/Heavy Load} - \$308 \text{ a w/Light Load}}{C_{\text{H}}(\overline{\text{CAS}}) - C_{\text{L}}(\overline{\text{CAS}})} \\ &= \frac{79 \text{ ns} - 72 \text{ ns}}{125 \text{ pF} - 50 \text{ pF}} = \frac{7 \text{ ns}}{75 \text{ pF}} \\ \$308a \text{ (actual)} &= \text{ (capacitance difference } \times \\ \text{ ratio} \text{ + } \$308a \text{ (specified)} \\ &= (250 \text{ pF} - 125 \text{ pF}) \frac{7 \text{ ns}}{75 \text{ pF}} + 79 \text{ ns} \\ &= 11.7 \text{ ns} + 79 \text{ ns} \\ &= 90.7 \text{ ns} @ 250 \text{ pF} \text{ load} \end{aligned}$ 

# PRELIMINARY

# NS32CG821A microCMOS Programmable 1M Dynamic RAM Controller/Driver

# **General Description**

National

The NS32CG821A dynamic RAM controller provides a low cost, single chip interface between dynamic RAM and the NS32CG16. The NS32CG821A generates all the required access control signal timing for DRAMs. An on-chip refresh request clock is used to automatically refresh the DRAM array. Refreshes and accesses are arbitrated on chip. If necessary, a WAIT output inserts wait states into memory access cycles, including burst mode accesses. RAS low time during refreshes and RAS precharge time after refreshes and back to back accesses are guaranteed through the insertion of wait states. Separate on-chip precharge counters for each RAS output can be used for memory interleaving to avoid delayed back to back accesses because of precharge.

# Features

- □ Allows zero wait state operation
- On chip high precision delay line to guarantee critical DRAM access timing parameters
- i microCMOS process for low power
- □ High capacitance drivers for RAS, CAS, WE and DRAM address on chip
- □ On chip support for page and static column DRAMs
- Byte enable signals on chip allow byte writing with no external logic
- □ Selection of controller speeds: 20 MHz and 25 MHz
- D On board access refresh arbitration logic

Largest Direct Drive

- Direct interface to the NS32CG16 microprocessor
- □ 4 RAS and 4 CAS drivers (the RAS and CAS configuration is programmable)

|              | Control                                      | # of Pins<br>(PLCC) | # of Address<br>Outputs                     | Largest<br>DRAM<br>Possible                                               | Direct Drive<br>Memory<br>Capacity |                                              |
|--------------|----------------------------------------------|---------------------|---------------------------------------------|---------------------------------------------------------------------------|------------------------------------|----------------------------------------------|
|              | NS32CG821A                                   | 68                  | 10                                          | 1 Mbit                                                                    | 8 Mbytes                           |                                              |
| Block Diagra | m                                            |                     |                                             |                                                                           |                                    |                                              |
|              |                                              | NS32CO              | 821A DRAM Cont                              | troller                                                                   | <b></b>                            |                                              |
|              | DRESS IN<br>DRESS IN<br>DRESS IN<br>DRESS IN | ->                  | 10<br>SS LATCH<br>UMN & BANK) 10            | MUX<br>→<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓<br>↓ |                                    | ADDRESS<br>OUT                               |
| мо           | DE LOAD                                      |                     |                                             | ſ                                                                         | REFRESH<br>ROW<br>COUNTER          |                                              |
| CONTROL      | - INPUTS                                     | LOGIC FO            | AND WAIT<br>DR MEMORY<br>ND REFRESH         |                                                                           | > WAT                              | ī                                            |
| SYSTE        |                                              |                     | TY CYCLE<br>RATOR,<br>Y LINE,<br>LECT LOGIC | RAS<br>GENERATOR                                                          |                                    | ➡ RAS0 - 3                                   |
|              |                                              |                     |                                             | CAS<br>GENERATOR                                                          |                                    | <ul> <li>▶ CAS0 - 3</li> <li>▶ WE</li> </ul> |

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#### 14.0 NSCG821A USER HINTS

# **1.0 Introduction**

The NS32CG821A is a CMOS Dynamic RAM controller that incorporates many advanced features including the capabilities of address latches, refresh counter, refresh clock, row, column and refresh address multiplexer, delay line, refresh/ access arbitration logic and high capacitive drivers. The programmable system interface allows the NS32CG16 microprocessor to directly interface via the NS32CG821A to DRAM arrays up to 8 Mbytes in size. (See *Figure 3* for an example.)

After power up, the NS32CG821A must first be reset and programmed before accessing the DRAM. The chip is programmed through the address bus.

#### Resetting

Due to the differences in power supply characteristics, the internal reset circuit may not always reset correctly. Therefore, an external (hardware) reset must be performed before programming the chip.

There are two methods of programming the chip. The first method, mode load only, is accomplished by asserting the signal mode load,  $\overline{ML}$ . A valid programming selection is presented on the row, column, bank and  $\overline{ECASO}$  inputs, then  $\overline{ML}$  is negated. When  $\overline{ML}$  is negated, the chip is programmed with the valid programming bits on the address bus.

The second method, chip selected access, is accomplished by asserting  $\overline{\text{ML}}$  and performing a chip selected access. When  $\overline{\text{CS}}$  and  $\overline{\text{TSO}}$  are asserted for the access, the chip is programmed. During this programming access, the programming bits affecting the wait logic become effective immediately, allowing the access to terminate. After the access,  $\overline{\text{ML}}$  is negated and the rest of the programming bits take effect.

Once the NS32CG821A has been programmed, a 60 ms initialization period is entered. During this time, the NS32CG821A controller performs refreshes to the DRAM array so further DRAM warm up cycles are unnecessary.

To access the DRAM, the signal ALE is asserted along with CS to ensure a valid DRAM access. ALE asserting sets an internal latch and only needs to be pulsed and not held throughout the entire access. Once CS and ALE are both asserted, WAIT is asserted, unless WAIT is programmed as OT and a non-delayed access occurs, and follows  $\overline{CS}$  until the rising clock edge. This is not a problem since the 32CG16 will not process the WAIT signal until the end of state T2. WAIT only has to guarantee that it meets the setup time to this edge of CLK on which it is sampled. On the next rising clock edge, RAS will be asserted for that access. The NS32CG821A will place the row address on the DRAM address bus, guarantee the programmed value of row address hold time of the DRAM, place the column address on the DRAM address bus, guarantee the programmed value of column address setup time and assert CAS. TSO can be asserted anytime after the clock edge which starts the access RAS. RAS and CAS will extend until TSO is negated.

The NS32CG821A has greatly expanded refresh capabilities compared to other DRAM controllers.

When using internal automatic refreshing, the NS32CG821A will generate an internal refresh request from the refresh request clock. The NS32CG821A will arbitrate between the refresh requests and accesses. Assuming an access is not currently in progress, a refresh will occur and on the next positive clock edge, refreshing will begin. If an access had been in progress, the refresh will begin after the access has terminated.

The controller has two types of refreshing available: conventional and staggered. Any refresh control mode can be used with internal refreshing. In a conventional refresh, all of the  $\overline{\text{RAS}}$  outputs will be asserted and negated at once. In a staggered refresh, the  $\overline{\text{RAS}}$  outputs will be asserted one positive clock edge apart.

The NS32CG821A has wait support available as programmable  $\overline{\text{WAIT}}$ , which connects directly to the NS32CG16  $\overline{\text{CWAIT}}$  pin. This signal is used by the on-chip arbiter to insert wait states to guarantee the arbitration between accesses and refreshes or precharge.

 $\overline{\text{WAIT}}$  is asserted during the start of the access (ALE and  $\overline{\text{CS}}$ ) and will negate a number of clock edges from the event that starts the access  $\overline{\text{RAS}}$ . After  $\overline{\text{WAIT}}$  is negated, it will stay negated until the next access.  $\overline{\text{WAIT}}$  can also be programmed to toggle with  $\overline{\text{ECAS}}$  inputs during a burst/page mode access.

WAIT can be dynamically delayed further through the WAITIN signal to the NS32CG821A.

The NS32CG821A has address latches, used to latch the bank, row and column address inputs. Once the address is latched, a column increment feature can be used to increment the column address. The address latches can also be programmed to be fall through.

The  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  drivers can be configured to drive a one, two, four or eight bank memory array. The  $\overline{\text{ECAS}}$  signals can then be used to select one of four  $\overline{\text{CAS}}$  drivers for byte writing with no external logic.

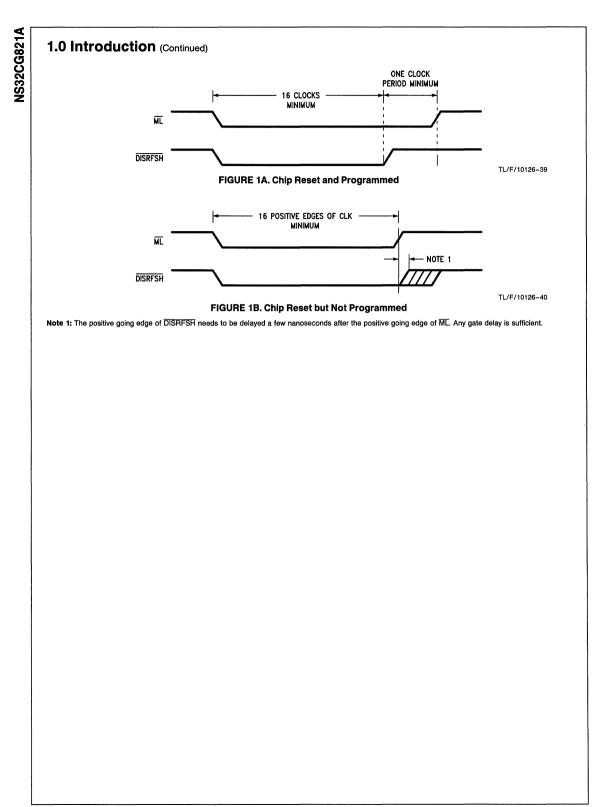
When configuring the NS32CG821A for more than one bank, memory interleaving can be used. By tying the low order address bits to the bank select lines, B0 and B1, sequential back to back accesses will not be delayed since the NS32CG821A has separate precharge counters per bank.

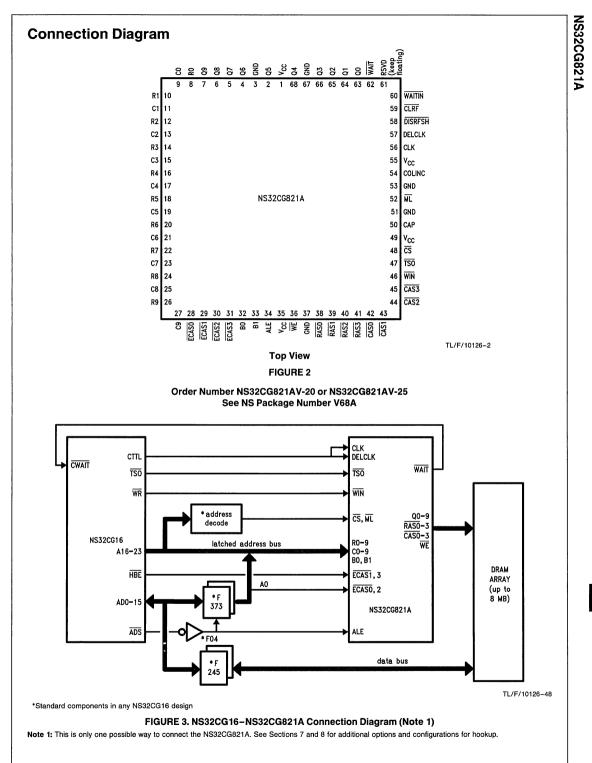
The following explains the terminology used in this data sheet. The terms negated and asserted are used. Asserted refers to a "true" signal. Thus, "ECASO asserted" means the ECASO input is at a logic 0. The term "COLINC asserted" means the COLINC input is at a logic 1. The term negated refers to a "false" signal. Thus, "ECASO negated" means the ECASO input is at a logic 1. The term "COLINC negated" means the ECASO input is at a logic 1. The term "COLINC negated" means the input COLINC is at a logic 0. The term "COLINC negated" means the input COLINC is at a logic 0. The table shown below clarifies this terminology.

| Signal      | Action   | Logic Level |
|-------------|----------|-------------|
| Active High | Asserted | High        |
| Active High | Negated  | Low         |
| Active Low  | Asserted | Low         |
| Active Low  | Negated  | High        |

#### **External Reset**

The power up state can again be entered by asserting  $\overline{ML}$  and  $\overline{DISRFSH}$  for a minimum of 16 positive edges of CLK. After resetting if the user negates  $\overline{DISRFSH}$  at least one CLK period before negating  $\overline{ML}$  as shown in *Figure 1A*,  $\overline{ML}$  negated will program the chip. If  $\overline{ML}$  is negated before  $\overline{DISRFSH}$  as shown in *Figure 1B*, the chip will not be programmed. After the chip is programmed, the 60 ms initialization period will be entered into if this is the first programming after power up or reset.





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#### 2.0 Signal Descriptions Pin Input/ Description Name Output 2.1 ADDRESS, R/W AND PROGRAMMING SIGNALS R0-9 ROW ADDRESS: These inputs are used to specify the row address during an access to the DRAM. They are T also used to program the chip when ML is asserted (except R10). C0-9 I COLUMN ADDRESS: These inputs are used to specify the column address during an access to the DRAM. They are also used to program the chip when $\overline{ML}$ is asserted (except C10). B0, B1 L BANK SELECT: Depending on programming, these inputs are used to select a group of RAS and CAS outputs to assert during an access. They are also used to program the chip when ML is asserted. ENABLE CAS: These inputs are used to enable a single or group of CAS outputs when asserted. In ECAS0-3 Т combination with the B0, B1 and the programming bits, these inputs select which CAS output or CAS outputs will assert during an access. The ECAS signals can also be used to toggle a group of CAS outputs for page mode accesses. They also can be used for byte write operations. WIN L WRITE ENABLE IN: This input is used to signify a write operation to the DRAM. The WE output follows this input. This input asserted will also cause CAS to delay to the next positive clock edge if address bit C9 is

|        |   | asserted during programming.                                                                                                                                          |
|--------|---|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| COLINC | I | <b>COLUMN INCREMENT:</b> When the address latches are used, this input functions as COLINC. Asserting this signal causes the column address to be incremented by one. |
| ML     | 1 | MODE LOAD: This input signal, when low, enables the internal programming register that stores the                                                                     |

|            |        | programming information.                                                                                                                                                                                                                                                                                                  |
|------------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.2 DRAM ( | ONTROL | SIGNALS                                                                                                                                                                                                                                                                                                                   |
| Q0-9       | 0      | <b>DRAM ADDRESS:</b> These outputs are the multiplexed output of the R0–9 and C0–9 and form the DRAM address bus. These outputs contain the refresh address whenever refreshing is taking place. They contain high capacitive drivers with $20\Omega$ series damping resistors.                                           |
| RAS0-3     | 0      | <b>ROW ADDRESS STROBES:</b> For an access, these outputs are asserted to latch the row address contained<br>on the outputs Q0–9 into the DRAM. For refreshing, the RAS outputs are used to latch the refresh row<br>address contained on the Q0–9 outputs in the DRAM. These outputs contain high capacitive drivers with |

|        |   | 20Ω series damping resistors.                                                                                                                                                                                                           |
|--------|---|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CAS0-3 | 0 | <b>COLUMN ADDRESS STROBES:</b> These outputs are asserted to latch the column address contained on the outputs $Q0-9$ into the DRAM. These outputs have high capacitive drivers with $20\Omega$ series damping resistors.               |
| WE     | 0 | <b>WRITE ENABLE:</b> This output asserted specifies a write operation to the DRAM. When negated, this output specifies a read operation to the DRAM. This output has a high capacitive driver and a $20\Omega$ series damping resistor. |

| 2.3 REFRES | H SIGNA | LS                                                                                                                                                                                                                                                                                                                                                                                   |
|------------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CLRF       | I       | CLEAR REFRESH: This pin, in conjunction with DISRFSH is used to clear the internal refresh counter.                                                                                                                                                                                                                                                                                  |
| DISRFSH    | Ι       | <b>DISABLE REFRESH:</b> When asserted with $\overline{ML}$ asserted for 16 positive edges of clock, the entire chip is reset and when negated with $\overline{CLRF}$ asserted clears the internal refresh address counter.                                                                                                                                                           |
| 2.4 MEMOR  | Y ACCES | S                                                                                                                                                                                                                                                                                                                                                                                    |
| ALE        | I       | <b>ADDRESS LATCH ENABLE:</b> When ALE asserted along with $\overline{CS}$ causes an internal latch to be set. Once this latch is set and precharge time has been met an access will start from the positive clock edge of CLK as soon as possible. If Address Latch (B <sub>0</sub> = 0) is programmed, the low going edge of this signal latches the bank, row, and column address. |
| CS         | I       | CHIP SELECT: This input signal must be asserted to enable an access.                                                                                                                                                                                                                                                                                                                 |
| TSO        | I       | <b>TIMING STATE OUTPUT:</b> This input signal must be asserted some time after the first positive clock edge after ALE has been asserted. When this signal is negated, RAS is negated for the access.                                                                                                                                                                                |

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| Pin<br>Name                      | Input/<br>Output          | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|----------------------------------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.4 MEMOR                        | RY ACCES                  | S (Continued)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| WAIT                             | 0                         | <b>WAIT:</b> This output can be programmed to insert wait states into a CPU access cycle. This signal can be delayed by a number of positive clock edges or negative clock levels of CLK, depending on how it is programmed, to increase the microprocessor's access cycle through the insertion of wait states.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| WAITIN                           | I                         | WAIT INCREASE: This input can be used to dynamically increase the number of positive clock edges of CLK until WAIT will be negated during a DRAM access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 2.5 POWER                        | RSIGNALS                  | S AND CAPACITOR INPUT                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| V <sub>CC</sub>                  | I                         | POWER: Supply Voltage.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| GND                              | I                         | GROUND: Supply Voltage Reference.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| CAP                              | 1                         | CAPACITOR: This input is used by the internal PLL for stabilization. The value of the ceramic capacitor                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|                                  |                           | should be 0.1 $\mu$ F and should be connected between this input and ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                  | wo clock i                | should be 0.1 μF and should be connected between this input and ground.<br>nputs to the NS32CG821A, CLK and DELCLK. These two clocks may both be tied to the same clock input, or<br>arate clocks, running at different frequencies, asynchronous to each other.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| There are t                      | wo clock i                | nputs to the NS32CG821A, CLK and DELCLK. These two clocks may both be tied to the same clock input, or                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| There are t<br>they may b        | wo clock i<br>e two sepa  | nputs to the NS32CG821A, CLK and DELCLK. These two clocks may both be tied to the same clock input, or<br>arate clocks, running at different frequencies, asynchronous to each other.<br>SYSTEM CLOCK: This input may be in the range of 0 Hz up to 25 MHz. This input is generally a constant<br>frequency but it may be controlled externally to change frequencies or perhaps be stopped for some arbitrary<br>period of time.<br>This input provides the clock to the internal state machine that arbitrates between accesses and refreshes.<br>This clock's positive edges and negative levels are used to extend the WAIT signal. This clock is also used<br>as the reference for the RAS precharge time and RAS low time during refresh.                                                                                      |
| There are t<br>they may b<br>CLK | wo clock ii<br>e two sepa | nputs to the NS32CG821A, CLK and DELCLK. These two clocks may both be tied to the same clock input, or<br>arate clocks, running at different frequencies, asynchronous to each other.<br><b>SYSTEM CLOCK:</b> This input may be in the range of 0 Hz up to 25 MHz. This input is generally a constant<br>frequency but it may be controlled externally to change frequencies or perhaps be stopped for some arbitrary<br>period of time.<br>This input provides the clock to the internal state machine that arbitrates between accesses and refreshes.<br>This clock's positive edges and negative levels are used to extend the WAIT signal. This clock is also used<br>as the reference for the RAS precharge time and RAS low time during refresh.<br>All memory accesses are assumed to be synchronous to the system clock CLK. |
| There are t<br>they may b        | wo clock i<br>e two sepa  | nputs to the NS32CG821A, CLK and DELCLK. These two clocks may both be tied to the same clock input, or<br>arate clocks, running at different frequencies, asynchronous to each other.<br>SYSTEM CLOCK: This input may be in the range of 0 Hz up to 25 MHz. This input is generally a constant<br>frequency but it may be controlled externally to change frequencies or perhaps be stopped for some arbitrary<br>period of time.<br>This input provides the clock to the internal state machine that arbitrates between accesses and refreshes.<br>This clock's positive edges and negative levels are used to extend the WAIT signal. This clock is also used<br>as the reference for the RAS precharge time and RAS low time during refresh.                                                                                      |

# 3.0 Memory Access

An access to DRAM is initiated by two input signals: ALE and  $\overline{CS}$ . The access is always terminated by one signal:  $\overline{TSO}$ . These input signals should be synchronous to the input clock, CLK. Once an access has been requested by  $\overline{CS}$ and ALE, the NS32CG821A will guarantee the following:

The NS32CG821A will have the row address valid to the DRAMs' address bus, Q0-9 given that the row address setup time to the NS32CG821A was met;

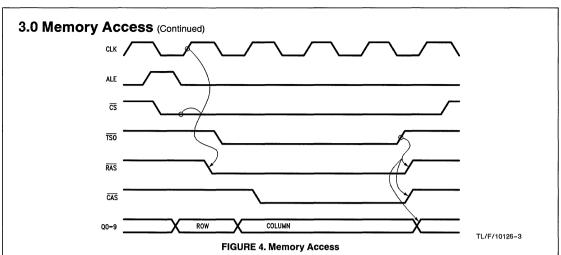
The NS32CG821A will bring the appropriate  $\overline{\text{RAS}}$  or  $\overline{\text{RASs}}$  low;

The NS32CG821A will guarantee the minimum row address hold time, before switching the internal multiplexer to place the column address on the DRAM address bus, Q0-9;

The NS32CG821A will guarantee the minimum column address setup time before asserting the appropriate  $\overline{CAS}$  or  $\overline{CASs}$ ;

The NS32CG821A will hold the column address valid the minimum specified column address hold time.

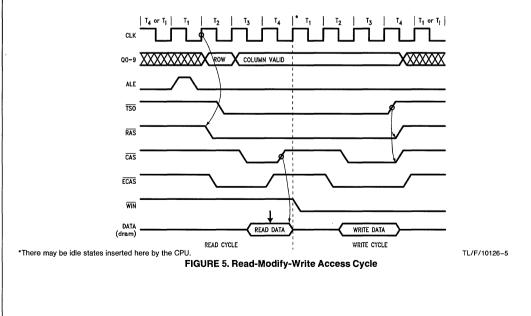
The memory access shown in *Figure 4* is selected by negating the input B1 during programming. This access mode al-



lows accesses to DRAM to always be initiated from the positive edge of the system input clock, CLK. To initiate an access, ALE is pulsed high and  $\overline{CS}$  is asserted. Pulsing ALE high and asserting  $\overline{CS}$ , sets an internal latch which requests an access. If the precharge time from the last access or DRAM refresh had been met and a refresh of DRAM was not in progress, the  $\overline{RAS}$  or group of  $\overline{RAS}$  would be initiated from the first positive edge of CLK. If a DRAM refresh is in progress or precharge time is required, the controller will wait until these events have taken place and assert  $\overline{RAS}$  on the next positive edge of CLK.

Once ALE and  $\overline{CS}$  are both asserted,  $\overline{WAIT}$  is asserted, unless  $\overline{WAIT}$  is programmed as OT and a non-delayed access occurs, and follows  $\overline{CS}$  until the rising clock edge. This is not a problem since the 32CG16 will not process the WAIT signal until the end of state T2. WAIT only has to guarantee that it meets the setup time to this edge of CLK on which it is sampled. Sometime after the first positive edge of CLK after ALE and  $\overline{CS}$  have been asserted, the input  $\overline{TSO}$  must be asserted. Once  $\overline{TSO}$  has been asserted,  $\overline{CS}$  can be negated. Once  $\overline{TSO}$  is negated,  $\overline{RAS}$  and  $\overline{CAS}$  will be negated. ALE can stay asserted several periods of CLK. However, ALE must be negated before or during the period of CLK in which  $\overline{TSO}$  is negated.

There are 2 methods by which this chip can be used to do read-modify-write access cycles. The first method involves doing a late write access where the  $\overline{\text{WIN}}$  input is asserted some delay after  $\overline{\text{CAS}}$  is asserted. The second method involves doing a page mode read access followed by a page mode write access with  $\overline{\text{RAS}}$  held low (see *Figure 5*).



# 3.0 Memory Access (Continued)

CASn must be toggled using the ECASn inputs and WIN has to be changed from negated to asserted (read to write) while CAS is negated. This method is better than changing WIN from negated to asserted in a late write access because here a problem may arise with DATA IN and DATA OUT being valid at the same time. This may result in a data line trying to drive two different levels simultaneously. The page mode method of a read-modify-write access allows the user to have transceivers in the system because the data in (read data) is guaranteed to be high impedance during the time the data out (write data) is valid.

# 4.0 Refresh Options

The NS32CG821A supports automatic internally controlled refresh. Different types of refreshes can be performed. These different types include all  $\overrightarrow{\mathsf{RAS}}$  refresh and staggered refresh.

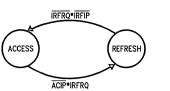
There are two inputs,  $\overline{\text{DISRFSH}}$  and  $\overline{\text{CLRF}}$ , associated with refresh. There are also ten programming bits; R0–1, R9, C0–6 and  $\overline{\text{ECAS0}}$  used to program the various types of refreshing.

The NS32CG821A will increment the refresh address counter automatically. The refresh address counter will be incremented once all the refresh  $\overline{\text{RASs}}$  have been negated.

In every combination of internal refresh and refresh type, the NS32CG821A is programmed to keep  $\overline{\text{RAS}}$  asserted a number of CLK periods. The values of  $\overline{\text{RAS}}$  low time during refresh are programmed with the programming bits R0 and R1.

## 4.1 AUTOMATIC INTERNAL REFRESH

The NS32CG821A has an internal refresh clock. The period of the refresh clock is generated from the programming bits C0-3. Every period of the refresh clock, an internal refresh request is generated. As long as a DRAM access is not currently in progress and precharge time has been met, the internal refresh request will generate an automatic internal refresh. If a DRAM access is in progress, the NS32CG821A on-chip arbitration logic will wait until the access is finished before performing the refresh. The refresh/access arbitration logic can insert a refresh cycle between two accesses. If the two accesses are back to back, the arbitration logic can insert a refresh cycle into the beginning of the next access. The CPU will wait to complete that access until the refresh cycle is completed. However, the refresh arbitration logic can not interrupt an access cycle in progress to perform a refresh. To enable automatic internally controlled refreshes, the input DISRFSH must be negated.



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Explanation of Terms

- IRFRQ = Internal ReFresh ReQuest of the NS32CG821A. IRFRQ has the ability to hold off a pending access.
- IRFIP = Internal ReFresh In Progress
- ACIP = ACcess In Progress. This means that either RAS is low for an access or is in the process of transitioning low for an access.

#### FIGURE 6. NS32CG821A Access/Refresh Arbitration State Program

#### 4.2 REFRESH CYCLE TYPES

Two different types of refresh cycles are available for use. The two different types are mutually exclusive and can be used with the internal refresh control. The two different refresh cycle types are: all  $\overline{\text{HAS}}$  refresh and staggered  $\overline{\text{HAS}}$  refresh. In all refresh cycle types, the  $\overline{\text{RAS}}$  precharge time is guaranteed: between the previous access  $\overline{\text{HAS}}$  ending and the refresh  $\overline{\text{RAS}}$  of starting; between refresh  $\overline{\text{RAS}}$  and access  $\overline{\text{RAS}}$  beginning; between burst refresh  $\overline{\text{RAS}}$ s.

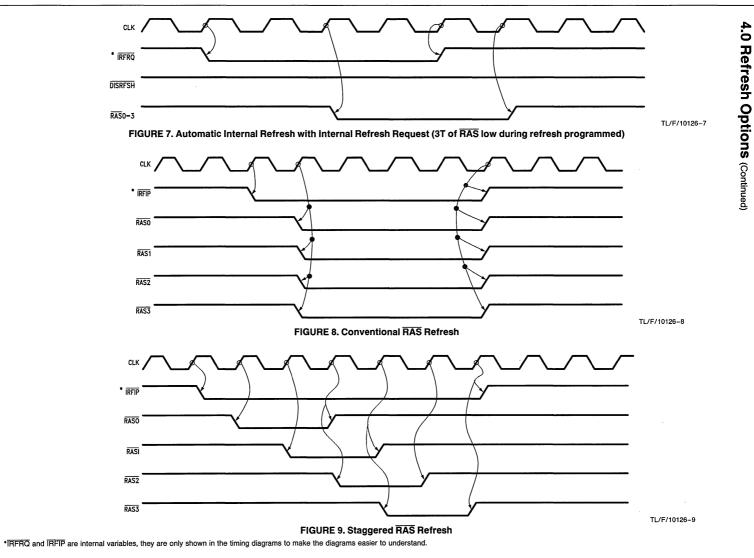
## 4.2.1 Conventional RAS Refresh

A conventional refresh cycle causes  $\overline{\text{RASO}}$ -3 to all assert from the first positive edge of CLK after refresh begins as shown in *Figure 8*.  $\overline{\text{RASO}}$ -3 will stay asserted until the number of positive edges of CLK programmed have passed. On the last positive edge,  $\overline{\text{RASO}}$ -3 will be negated and the refresh cycle will end. This type of refresh cycle is programmed by negating address bit R9 during programming.

## 4.2.2 Staggered RAS Refresh

A staggered refresh staggers each  $\overline{\text{RAS}}$  or group of  $\overline{\text{RASs}}$  by a positive edge of CLK as shown in *Figure 9*. The number of  $\overline{\text{RASs}}$ , which will be asserted on each positive edge of CLK, is determined by the  $\overline{\text{RAS}}$ ,  $\overline{\text{CAS}}$  configuration mode programming bits C4–C6. If single  $\overline{\text{RAS}}$  outputs are selected during programming, then each  $\overline{\text{RAS}}$  will assert on successive positive edges of CLK. If two  $\overline{\text{RAS}}$  outputs are selected during programming then  $\overline{\text{RAS}}$  on  $\overline{\text{RAS}}$  in the first positive edge of CLK after refresh cycle begins.  $\overline{\text{RAS2}}$  and  $\overline{\text{RAS3}}$  will assert on the second positive edge of CLK after refresh cycle begins. If all  $\overline{\text{RAS}}$  outputs were selected during programming, all  $\overline{\text{RAS}}$  outputs would assert on the first positive edge of CLK after refresh cycle begins. Each  $\overline{\text{RAS}}$  or group of  $\overline{\text{RAS3}}$  will meet the programmed  $\overline{\text{RAS3}}$  low time and then negate.

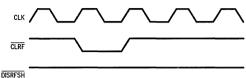
## NS32CG821A



# 4.0 Refresh Options (Continued)

#### 4.3 CLEARING THE REFRESH ADDRESS COUNTER

The refresh address counter can be cleared by asserting CLRF while DISRFSH is negated as shown in Figure 10. This can be used prior to a burst refresh of the entire memory array. An end-of-count signal can be generated from the Q DRAM address outputs of the NS32CG821A and used to negate CLRF.



TL/F/10126-10 FIGURE 10. Clearing the Refresh Address Counter

# 5.0 Wait State Support

Wait states allow a CPU's access cycle to be increased by one or multiple CPU clock periods. By increasing the CPU's access cycle, all signals associated with that access cycle are extended. The CPU samples a wait line to determine if another clock period should be inserted into the access cvcle. If another clock period is inserted, the CPU will continue to sample the input every CPU clock period until the input signal changes polarity, allowing the CPU access cycle to terminate. The user determines which value to select for WAIT depending upon the CPU speed used and where the user wants the CPU to sample its wait input during an access cycle.

The decision to terminate the CPU access cycle is directly affected by the speed of the DRAMs used. The system designer must ensure that the data from the DRAMs will be present for the CPU to sample or that the data has been written to the DRAM before allowing the CPU access cycle to terminate.

The insertion of wait states also allows a CPU's access cvcle to be extended until the DRAM access has taken place. The NS32CG821A inserts wait states into CPU access cycles due to; guaranteeing precharge time, refresh currently in progress, user programmed wait states, and the WAITIN signal being asserted. If one of these events is taking place and the CPU starts an access, the NS32CG821A will insert wait states into the access cycle, thereby increasing the length of the CPU's access. Once the event has been completed, the NS32CG821A will allow the access to take place and stop inserting wait states.

There are six programming bits, R2-R7; an input, WAITIN; and an output that functions as WAIT.

## 5.1 WAIT OUTPUT

If WAIT is sampled asserted by the CPU, wait states (extra clock periods) are inserted into the current access cycle as shown in Figure 11. Once WAIT is sampled negated, the access cycle is completed by the CPU. WAIT is asserted at the beginning of a chip selected access and is programmed to negate a number of positive edges and/or negative levels of CLK from the event that starts the access. WAIT can also be programmed to function in page/burst mode applications. Once WAIT is negated during an access, and the ECAS inputs are negated with TSO asserted. WAIT can be programmed to toggle, following the ECAS inputs. Once TSO is negated, ending the access, WAIT will stay negated until the next chip selected access.

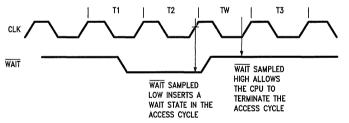


FIGURE 11. WAIT Type Output

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## 5.1.1 Wait during Single Accesses

WAIT can be programmed to delay a number of positive edges and/or negative levels of CLK. These options are programmed through address bits R2 and R3 at programming time. The user is given four options described below. 0T during non delayed and delayed acceses:  $\overrightarrow{WAIT}$  will stay negated during a non-delayed access as shown in *Figure 12*. During an access that is delayed,  $\overrightarrow{WAIT}$  will assert at the start of the access ( $\overrightarrow{CS}$  and ALE) and negate from the positive edge of  $\overrightarrow{OLK}$  that starts  $\overrightarrow{RAS}$  for that access as shown in *Figure 13*.

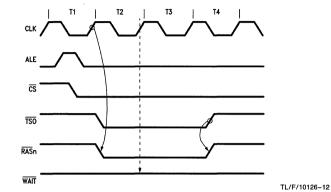


FIGURE 12. Non-Delayed Access with WAIT 0T (WAIT is Sampled at the End of the "T2" Clock State)

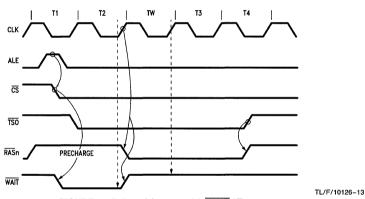


FIGURE 13. Delayed Access with WAIT 0T ("2T" RAS Precharge, WAIT is Sampled at the End of the "T2" Clock State)

OT during non-delayed accesses and  $\frac{1}{2}$ T during delayed accesses: WAIT will stay negated during a non-delayed access as shown in *Figure 14*. During an access that is delayed, WAIT will assert at the start of the access (CS and

ALE) and negate on the negative level of CLK after the positive edge of CLK that asserted  $\overline{\text{RAS}}$  for that access as shown in *Figure 15*.

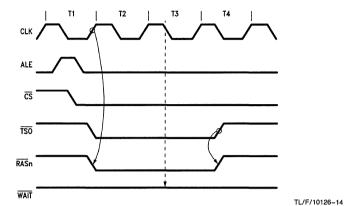


FIGURE 14. Non-Delayed Access with WAIT OT (WAIT is Sampled at the "T3" Falling Clock Edge)

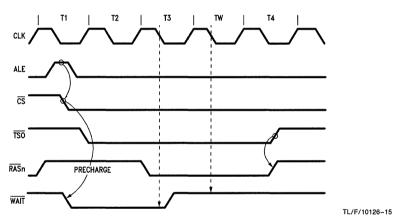
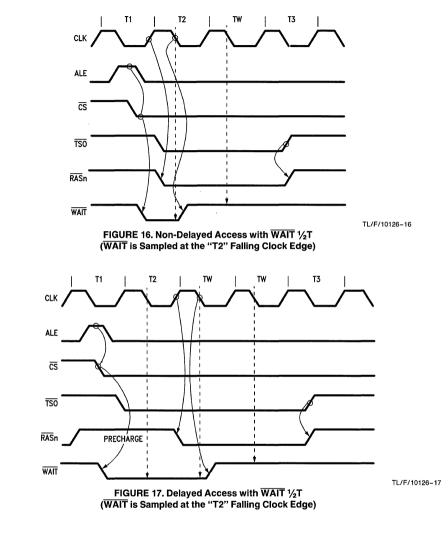


FIGURE 15. Delayed Access with WAIT 1/2T (WAIT is Sampled at the "T3" Falling Clock Edge)

 $1/_2T$  during non-delayed and delayed accesses: WAIT will assert when ALE is asserted and CS is asserted. WAIT will then negate on the negative level of CLK after the positive edge of CLK that asserts RAS for the access as shown in

Figure 16. During delayed accesses in both modes,  $\overline{WAIT}$  will assert at the start of the access and negate on the negative level of CLK after the positive edge of CLK that started  $\overline{RAS}$  for that access as shown in Figure 17.



and the second

1T during non-delayed and delayed accesses. WAIT will assert from ALE asserted and  $\overline{CS}$  asserted. WAIT will negate from the next positive edge of CLK that asserts RAS for the access as shown in *Figure 18*. During delayed accesses,

WAIT will assert at the beginning of the access and will negate on the first positive edge of CLK after the positive edge of CLK that starts  $\overline{\text{RAS}}$  for the access as shown in *Figure 19.* 

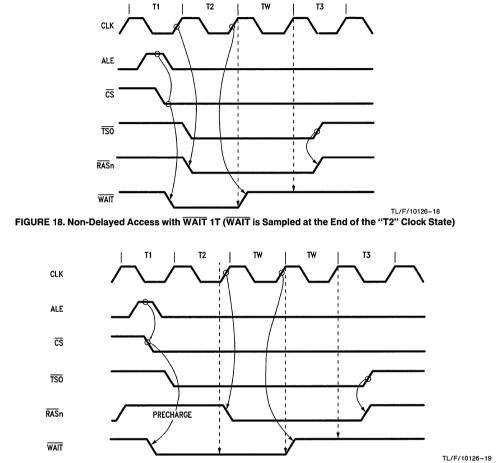


FIGURE 19. Delayed Access with WAIT 1T (WAIT is Sampled at the End of the "T2" Clock State)

NS32CG821A

When ending  $\overline{WAIT}$  from a negative level of CLK; if  $\overline{RAS}$  is asserted while CLK is high then  $\overline{WAIT}$  will negate from the negative edge of CLK; if  $\overline{RAS}$  is asserted while CLK is low then  $\overline{WAIT}$  will negate from  $\overline{RAS}$  asserting. When ending  $\overline{WAIT}$  from a positive edge of CLK, the user can think of the positive edge of CLK that starts  $\overline{RAS}$  as 0T and the next positive edge of CLK that starts  $\overline{RAS}$  can be thought of as 0T and that next positive edge as 1T.

## 5.1.2 Wait during Page Burst Accesses

 $\overline{\text{WAIT}}$  can be programmed to function differently during page/burst types of accesses. During a page/burst access, the ECAS inputs will be asserted then negated while  $\overline{\text{TSO}}$  is asserted. Through address bits R4 and R5,  $\overline{\text{WAIT}}$  can be programmed to assert and negate during this type of access. The user is given four programming options described below.

No Wait States: In this case, WAIT will remain negated even if the ECAS inputs are toggled as shown in *Figure 20*.

0T: WAIT will be asserted when the ECAS inputs are negated with TSO remaining asserted. When a single or group of ECAS inputs are asserted, WAIT will be negated as shown in *Figure 21*.

1/2T: WAIT will be asserted when the ECAS inputs are negated with TSO remaining asserted. When a single or group of ECAS inputs are asserted again, WAIT will be negated from the first negative level of CLK after a single ECAS or group of ECASs are asserted as shown in *Figure 22*.

1T: WAIT will be asserted when the ECAS inputs are negated with TSO remaining asserted. When a single or group of ECAS inputs are asserted again, WAIT will be negated from the first positive edge of CLK after a single ECAS or group of ECASs are asserted as shown in *Figure 23*.

When ending  $\overline{WAIT}$  from a negative level of CLK; if the  $\overline{ECASs}$  are asserted while CLK is high then  $\overline{WAIT}$  will negate from the negative edge of CLK, if the  $\overline{ECASs}$  are asserted while CLK is low then  $\overline{WAIT}$  will negate from the  $\overline{ECASs}$  asserting. When ending  $\overline{WAIT}$  from a positive edge of CLK, the positive edge of CLK that  $\overline{ECAS}$  is setup to can be thought of as 1T.

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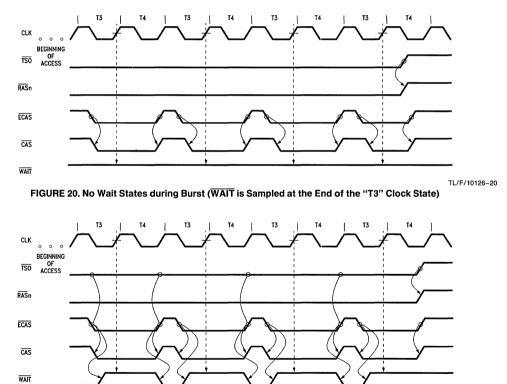


FIGURE 21. 0T during Burst (WAIT is Sampled at the End of the "T3" Clock State)

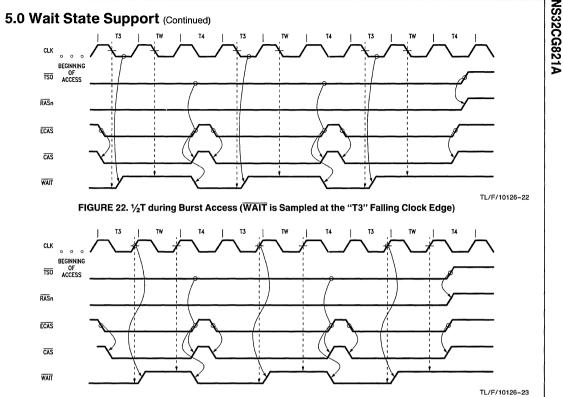
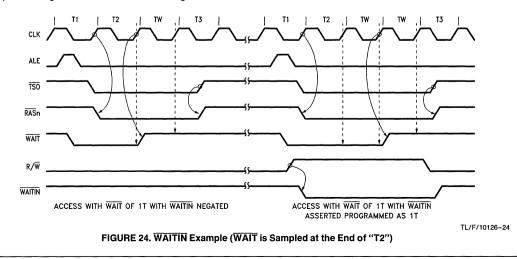


FIGURE 23. 1T during Burst Access (WAIT is Sampled at the End of the "T3" Clock State)

#### 5.2 DYNAMICALLY INCREASING THE NUMBER OF WAIT STATES

The user can increase the number of positive edges of CLK before  $\overline{WAIT}$  is negated. With the input  $\overline{WAITIN}$  asserted, the user can delay  $\overline{WAIT}$  negating either one or two more positive edges of CLK. The number of edges is programmed through address bit R6. If the user is increasing the number of positive edges in a delay that contains a negative level, the positive edges will be met before the negative level.



# 5.0 Wait State Support (Continued) 5.3 GUARANTEEING RAS LOW TIME

# AND RAS PRECHARGE TIME

The NS32CG821A will guarantee  $\overline{\text{RAS}}$  precharge time between accesses; between refreshes; and between access and refreshes. The programming bits R0 and R1 are used to program combinations of  $\overline{\text{RAS}}$  precharge time and  $\overline{\text{RAS}}$  low time referenced by positive edges of CLK.  $\overline{\text{RAS}}$  low time is programmed for refreshes only. During an access, the system designer guarantees the time  $\overline{\text{RAS}}$  is asserted through the NS32CG821A wait logic. Since inserting wait states into an access increases the length of the CPU signals which are used to create ALE and  $\overline{\text{TSO}}$ , the time that  $\overline{\text{RAS}}$  is asserted can be guaranteed.

Precharge time is also guaranteed by the NS32CG821A. Each  $\overline{\text{RAS}}$  output has a separate positive edge of CLK counter. TSO is negated setup to a positive edge of CLK to terminate the access. That positive edge is 1T. The next positive edge is 2T.  $\overline{\text{RAS}}$  will not be asserted until the programmed number of positive edges of CLK have passed. Once the programmed precharge time has been met,  $\overline{\text{RAS}}$  will be asserted from the positive edge of CLK. However, since there is a precharge counter per  $\overline{\text{RAS}}$ , an access using another  $\overline{\text{RAS}}$  will not be delayed. Precharge time before a refresh is always referenced from the access  $\overline{\text{RAS}}$  negating before  $\overline{\text{RAS}}$  of the refresh asserting. After a refresh, precharge time is referenced from  $\overline{\text{RAS}}$  anguting, for the refresh, to the access  $\overline{\text{RAS}}$  asserting.

# 6.0 Additional Access Support Features

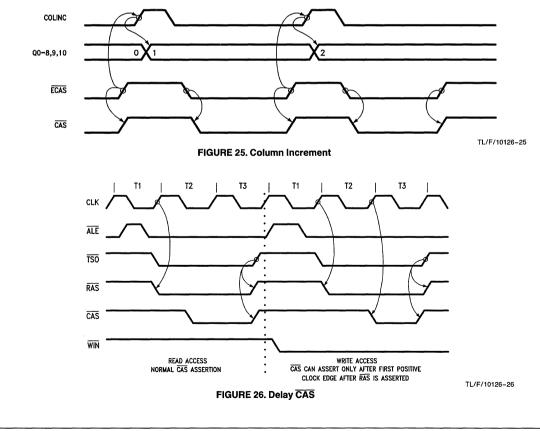
To support the different modes of accessing, the NS32CG821A have multiple access features. These features allow the user to take advantage of CPU or DRAM functions. These additional features include: address latches and column increment for page/burst mode support; and delay  $\overline{CAS}$ , to allow the user with a multiplexed bus to ensure valid data is present before  $\overline{CAS}$  is asserted.

# 6.1 ADDRESS LATCHES AND COLUMN INCREMENT

The address latches can be programmed, through programming bit B0, to either latch the address or remain permanently in fall-through mode. If the address latches are used to latch the address, the rising edge of ALE places the latches in fall-through. Once ALE is negated, the address present on the row, column and bank inputs is latched.

Once the address is latched, the column address can be incremented with the input COLINC. With COLINC asserted, the column address is incremented.

If COLINC is asserted with all of the bits of the column address asserted, the column address will return to zero. COL-INC can be used for sequential accesses of static column DRAMs. COLINC can also be used with the ECAS inputs to support sequential accesses to page mode DRAMs as shown in *Figure 25*. COLINC should only be asserted during an access.



# 6.0 Additional Access Support Features (Continued)

# 6.2 DELAY CAS DURING WRITE ACCESSES

Address bit C9 asserted during programming will cause  $\overline{CAS}$  to be delayed until the first positive edge of CLK after  $\overline{RAS}$  is asserted when the input  $\overline{WIN}$  is asserted. Delaying  $\overline{CAS}$  during write accesses ensures that the data to be written to DRAM will be setup to  $\overline{CAS}$  asserted as shown in *Figure 26*. If the possibility exists that data still may not be present after the first positive edge of CLK,  $\overline{CAS}$  can be delayed further with the  $\overline{ECAS}$  inputs. If address bit C9 is negated during programming, read and write accesses will be treated the same (with regard to  $\overline{CAS}$ ).

# 7.0 RAS and CAS Configuration Modes

The NS32CG821A allow the user to configure the DRAM array to contain one, two, four or eight banks of DRAM. Depending on the functions used, certain considerations must be used when determining how to set up the DRAM array. Programming address bits C4, C5 and C6 along with bank selects, B0–1, and CAS enables, ECAS0–3, determine which RAS or group of RASs and which CAS or group of CASs will be asserted during an access. Different memory schemes are described. The NS32CG821A is specified driving a heavy load of 72 DRAMs, representing four banks

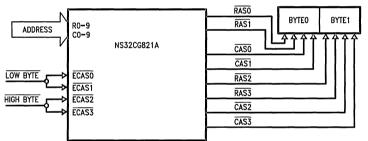
of DRAM with 16-bit words and 2 parity bits. The NS32CG821A can drive more than 72 DRAMs, but the AC timing must be increased. Since the RAS and CAS outputs are configurable, all RAS and CAS outputs should be used for the maximum amount of drive.

## 7.1 BYTE WRITING

By selecting a configuration in which all  $\overrightarrow{CAS}$  outputs are selected during an access, the  $\overrightarrow{ECAS}$  inputs enable a single or group of  $\overrightarrow{CAS}$  outputs to select a byte (or bytes) in a word. In this case, the  $\overrightarrow{RAS}$  outputs are used to select which of up to 4 banks is to be used as shown in *Figure 29*. In systems with a word size of 16 bits, the byte enables can be gated with a high order address bit to produce four byte enables which gives an equivalent to 8 banks of 16-bit words as shown in *Figure 30*. If less memory is required, each  $\overrightarrow{CAS}$  should be used to drive each nibble in the 16-bit word as shown in *Figures 27* and *28*.

#### 7.2 MEMORY INTERLEAVING

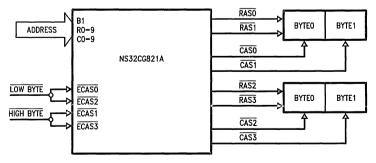
Memory interleaving allows the cycle time of DRAMs to be reduced by having sequential accesses to different memory banks. Since the NS32CG821A have separate precharge counters per bank, sequential accesses will not be delayed if the accessed banks use different RAS outputs. To ensure different RAS outputs will be used, a mode is selected where either one or two RAS outputs will be asserted during an access. The bank select or selects, B0 and B1, are then tied to the least significant address bits, causing a different

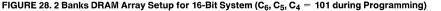


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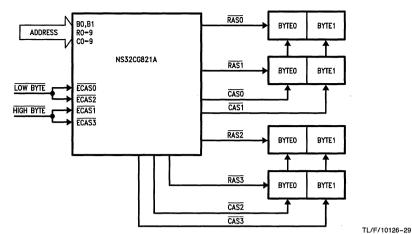
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FIGURE 27. 1 Bank DRAM Array Setup for 16-Bit System ( $C_6$ ,  $C_5$ ,  $C_4 = 011$  during Programming)

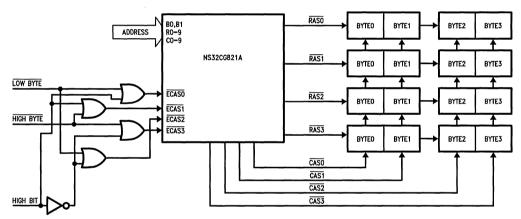




# 7.0 RAS and CAS Configuration Modes (Continued)







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FIGURE 30. 8 Bank DRAM Array for 16-Bit System (C<sub>6</sub>, C<sub>5</sub>, C<sub>4</sub> = 1, 1, 0 during Programming)

# 7.0 RAS and CAS Configuration Modes (Continued)

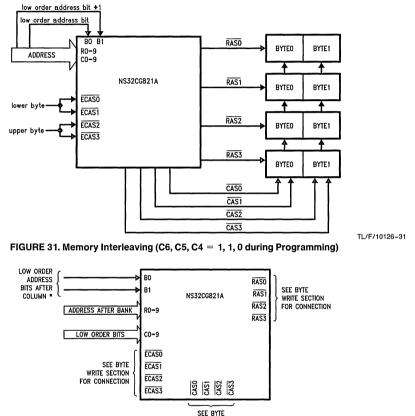
group of RASs to assert during each sequential access as shown in Figure 31. In this figure there should be at least one clock period of all RAS's negated between different RAS's being asserted to avoid the condition of a CAS before RAS refresh cycle.

#### 7.3 PAGE/BURST MODE

In a static column, page or burst mode system, the least significant bits must be tied to the column address in order

to ensure that the page/burst accesses are to sequential memory addresses, as shown in Figure 32. The ECAS inputs may then be toggled with the NS32CG821A's address latches in fall-through mode, while TSO is asserted. The ECAS inputs can also be used to select individual bytes. In page or static column modes, the two address bits after the page size can be tied to the bank select inputs to select a new bank if the page size is exceeded.

NS32CG821A



WRITE SECTION FOR CONNECTION

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\*See table below for row, column & bank address bit map. A0 is used for byte addressing in this example.

| Addresses         | Page Mode/Static Column Mode Page Size |                       |                |  |  |  |  |  |  |
|-------------------|----------------------------------------|-----------------------|----------------|--|--|--|--|--|--|
| Autresses         | 256 Bits/Page                          | 512 Bits/Page         | 1024 Bits/Page |  |  |  |  |  |  |
| Column<br>Address | C0-7 = A1-8<br>C8-9 = X                | C0-8 = A1-9<br>C9 = X | C0-9 = A1-10   |  |  |  |  |  |  |
| Row<br>Address    | x                                      | х                     | х              |  |  |  |  |  |  |
| B0                | A9                                     | A10                   | A11            |  |  |  |  |  |  |
| B1                | A10                                    | A11                   | A12            |  |  |  |  |  |  |

X = DON'T CARE, the user can do as he pleases.

FIGURE 32. Page, Static Column, Mode System

# 8.0 Programming and Resetting

The NS32CG821A must be programmed by one of two possible programming sequences before it can be used. Once the chip is programmed, the bits effecting the wait logic become effective immediately, thus allowing the programming bus cycle to end. At power up, the NS32CG821A must be externally reset before programming. Initially, the programming bits are in an undefined state. After programming, the NS32CG821A enters a 60 ms initialization period. During this initialization period, the NS32CG821A performs refreshes about every 15 us; this makes further DRAM warmup cycles unnecessary. The chip can be programmed as many times as the user wishes. After the first programming, the 60 ms initialization period will not be entered into unless the chip is reset. During the 60 ms initialization period, internal refreshes are taking place and the CPU is not allowed to enter into a memory access cycle. If a memory access is attempted, the NS32CG821A will send out wait states into the processor until initialization is complete. The actual initialization time period is given by the following formula:

T = 4096\*(Clock Divisor Select) \*(Refresh Clock Fine Tune) /(DELCK Frequency)

#### 8.1 MODE LOAD ONLY PROGRAMMING

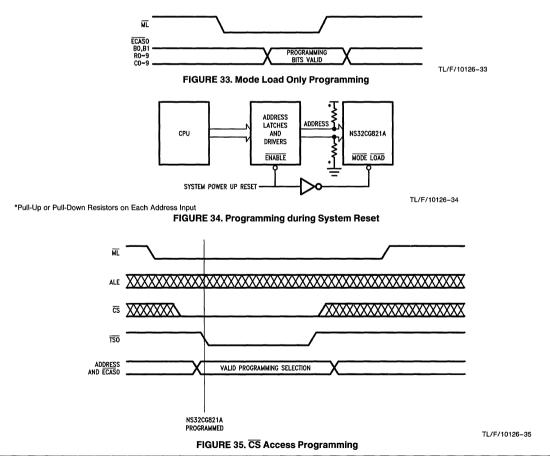
MODE LOAD,  $\overline{\text{ML}}$ , asserted enables an internal 23-bit programmable register. To use this method, the user asserts

 $\overline{\text{ML}}$ , enabling the internal programming register. After  $\overline{\text{ML}}$  is asserted, a valid programming selection is placed on the address bus (and ECAS0), then  $\overline{\text{ML}}$  is negated. When  $\overline{\text{ML}}$  is negated, the value on the address bus (and ECAS0) is latched into the internal programming register and the NS32CG821A is programmed, as shown in *Figure 33*. After  $\overline{\text{ML}}$  is negated, the NS32CG821A will enter the 60 ms initialization period only if this is the first programming after power up or reset.

Using this method, a set of transceivers on the address bus can be put at TRI-STATE® by the system reset signal. A combination of pull-up and pull-down resistors can be used on the address inputs of the NS32CG821A to select the programming values, as shown in *Figure 34*.

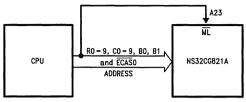
#### 8.2 CHIP SELECTED ACCESS PROGRAMMING

The chip can also be programmed by asserting  $\overline{\text{ML}}$  and performing a chip selected access. ALE is disabled internally until after programming. To program the chip using this method,  $\overline{\text{ML}}$  is asserted. After  $\overline{\text{ML}}$  is asserted,  $\overline{\text{CS}}$  is asserted at a valid programming selection is placed on the address bus. When  $\overline{\text{TSO}}$  is asserted, the chip is programmed with the programming selection on the address bus. After  $\overline{\text{TSO}}$  is negated,  $\overline{\text{ML}}$  can be negated as shown in *Figure 35*.



# 8.0 Programming and Resetting (Continued)

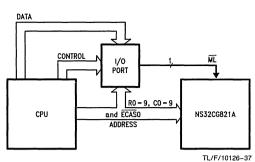
Using this method, various programming schemes can be used. For example if extra upper address bits are available, an unused high order address bit can be tied to the signal ML. Using this method, one need only write to a page of memory, thus asserting the high order bit and in turn programming the chip as shown in *Figure 36*.



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#### FIGURE 36. Programming the NS32CG821A through the Address Bus Only

An I/O port can also be used to assert  $\overline{ML}$ . After  $\overline{ML}$  is asserted, a chip selected access can be performed to program the chip. After the chip selected access,  $\overline{ML}$  can be negated through the I/O port as shown in *Figure 37*.



#### FIGURE 37. Programming the NS32CG821A through the Address Bus and an I/O Port

Another simple way the chip can be programmed is the first write after system reset. This method requires only a flip-flop and an OR gate as shown in *Figure 38*. At reset, the flip-flop is preset, which pulls the  $\overline{Q}$  output low. Since  $\overline{WR}$  is negated,  $\overline{ML}$  is not enabled. The first write access is used to program the chip. When  $\overline{WR}$  is asserted,  $\overline{ML}$  is asserted.  $\overline{WR}$  negated clocks the flip-flop, negates  $\overline{ML}$ , and programs the NS32CG821A with the address and  $\overline{ECASO}$  available at that time.  $\overline{CS}$  does not need to be asserted using this method.

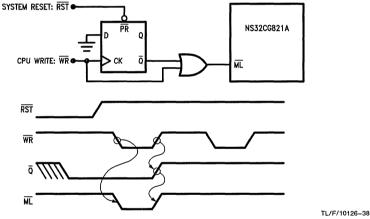


FIGURE 38. Programming the NS32CG821A on the First CPU Write after Power Up

NS32CG821A

# 8.0 Programming and Resetting (Continued) 8.4 PROGRAMMING BIT DEFINITIONS (Notes 1 and 2)

| Symbol             | Description                                                                                                                                                                           |
|--------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B0                 | Address Latch Mode                                                                                                                                                                    |
| 0                  | ALE asserted latches the input row, column and bank address.                                                                                                                          |
| 1                  | The row, column and bank latches are fall through.                                                                                                                                    |
| C9                 | Delay CAS during WRITE Accesses                                                                                                                                                       |
| 0                  | CAS is treated the same for both READ and WRITE accesses.                                                                                                                             |
| 1                  | During WRITE accesses, CAS will be asserted by the event that occurs last: CAS asserted by the internal delay line or CAS asserted on the positive edge of CLK after RAS is asserted. |
| C8                 | Row Address Hold Time                                                                                                                                                                 |
| 0                  | Row Address Hold Time = 25 ns minimum                                                                                                                                                 |
| 1                  | Row Address Hold Time = 15 ns minimum                                                                                                                                                 |
| C7                 | Column Address Setup Time                                                                                                                                                             |
| 0                  | Column Address Setup Time = 10 ns minimum                                                                                                                                             |
| 1                  | Column Address Setup Time = 0 ns minimum                                                                                                                                              |
| C6, C5, C4         | RAS and CAS Configuration Modes                                                                                                                                                       |
| 0, 1, 1            | RAS0-3 and CAS0-3 are all selected during an access. ECASn must be asserted for CASn to be asserted.                                                                                  |
|                    | B1, B0 are not used during an access.                                                                                                                                                 |
| 1, 0, 1            | RAS and CAS pairs are selected by B1. ECASn must be asserted for CASn to be asserted.                                                                                                 |
|                    | $B1 = 0$ during an access selects $\overline{RAS0} - 1$ and $\overline{CAS0} - 1$ .                                                                                                   |
|                    | B1 = 1 during an access selects $\overline{RAS2}$ -3 and $\overline{CAS2}$ -3.                                                                                                        |
|                    | B0 is not used during an access.                                                                                                                                                      |
| 1, 1, 0            | RAS singles are selected by B0-1. CAS0-3 are all selected. ECASn must be asserted for CASn to be asserted.                                                                            |
|                    | $B1 = 0, B0 = 0$ during an access selects $\overline{RAS0}$ and $\overline{CAS0}$ -3.                                                                                                 |
|                    | $B1 = 0$ , $B0 = 1$ during an access selects $\overline{RAS}1$ and $\overline{CAS}0-3$ .                                                                                              |
|                    | $B1 = 1, B0 = 0$ during an access selects $\overline{RAS2}$ and $\overline{CAS0}$ -3.                                                                                                 |
|                    | $B1 = 1, B0 = 1$ during an access selects $\overline{RAS3}$ and $\overline{CAS0-3}$ .                                                                                                 |
| C3                 | Refresh Clock Fine Tune Divisor                                                                                                                                                       |
| 0                  | Divide delay line/refresh clock further by 30 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 15 $\mu$ s                                                                             |
|                    | refresh period).                                                                                                                                                                      |
| 1                  | Divide delay line/refresh clock further by 26 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 13 $\mu$ s refresh period).                                                            |
| C2, C1, C0         | Delay Line/Refresh Clock Divisor Select                                                                                                                                               |
|                    |                                                                                                                                                                                       |
| 0, 0, 0<br>0, 0, 1 | Divide DELCLK by 10 to get as close to 2 MHz as possible.<br>Divide DELCLK by 9 to get as close to 2 MHz as possible.                                                                 |
| 0, 1, 0            | Divide DELCLK by 8 to get as close to 2 MHz as possible.                                                                                                                              |
| 0, 1, 1            | Divide DELCLK by 7 to get as close to 2 MHz as possible.                                                                                                                              |
| 1, 0, 0            | Divide DELCLK by 6 to get as close to 2 MHz as possible.                                                                                                                              |
| 1, 0, 1            | Divide DELCLK by 5 to get as close to 2 MHz as possible.                                                                                                                              |
| 1, 1, 0            | Divide DELCLK by 4 to get as close to 2 MHz as possible.                                                                                                                              |
| 1, 1, 1            | Divide DELCLK by 3 to get as close to 2 MHz as possible.                                                                                                                              |
| R9                 | Refresh Mode Select                                                                                                                                                                   |
| 0                  | RAS0-3 will all assert and negate at the same time during a refresh.                                                                                                                  |
| 1                  | Staggered Refresh. RAS outputs during refresh are separated by one positive clock edge. Depending on the                                                                              |
|                    | configuration mode.                                                                                                                                                                   |
| R6                 | Add Wait States to the Current Access if WAITIN is Low.                                                                                                                               |
| 0                  | WAIT will be delayed by one additional positive edge of CLK.                                                                                                                          |
| 1                  | WAIT will be delayed by two additional positive edges of CLK.                                                                                                                         |

# NS32CG821A

# 8.0 Programming and Resetting (Continued)

8.4 PROGRAMMING BIT DEFINITIONS (Continued)

| Symbol | Description                                                                                                                                                              |
|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R5, R4 | WAIT during Burst (See Section 5.1.2)                                                                                                                                    |
| 0, 0   | NO WAIT STATES; WAIT will remain negated during burst portion of access.                                                                                                 |
| 0, 1   | 1T; $\overline{WA T}$ will assert when the ECAS inputs are negated with TSO asserted. WAIT will negate from the positive edge of CLK after the ECASs have been asserted. |
| 1,0    | $1/_2$ T; WAIT will assert when the ECAS inputs are negated with TSO asserted. WAIT will negate on the negative level of CLK after the ECASs have been asserted.         |
| 1, 1   | 0T; WAIT will assert when the $\overline{\text{ECAS}}$ inputs are negated. WAIT will negate when the $\overline{\text{ECAS}}$ inputs are asserted.                       |
| R3, R2 | WAIT Delay Times (See Section 5.1.1)                                                                                                                                     |
| 0, 0   | NO WAIT STATES; WAIT will remain high during non-delayed accesses. WAIT will negate when RAS is negated during delayed accesses.                                         |
| 0, 1   | $1/_2$ T; WAIT will negate on the negative level of CLK, after the access RAS.                                                                                           |
| 1,0    | NO WAIT STATES, ½ T; WAIT will remain high during non-delayed accesses. WAIT will negate on the negative level of CLK, after the access RAS, during delayed accesses.    |
| 1, 1   | 1T; $\overline{WAIT}$ will negate on the positive edge of CLK after the access $\overline{RAS}$ .                                                                        |
| R1, R0 | RAS Low and RAS Precharge Time                                                                                                                                           |
| 0, 0   | $\overline{RAS}$ asserted during refresh = 2 positive edges of CLK.<br>$\overline{RAS}$ precharge time = 1 positive edge of CLK.                                         |
| 0, 1   | $\overline{RAS}$ asserted during refresh = 3 positive edges of CLK.<br>$\overline{RAS}$ precharge time = 2 positive edges of CLK.                                        |
| 1, 0   | $\overline{\text{RAS}}$ asserted during refresh = 2 positive edges of CLK.<br>$\overline{\text{RAS}}$ precharge time = 2 positive edges of CLK.                          |
| 1, 1   | $\overline{RAS}$ asserted during refresh = 4 positive edges of CLK.<br>RAS precharge time = 3 positive edges of CLK.                                                     |

Note 1: During programming  $\overline{ECAS_0}$ , B<sub>1</sub>, R<sub>7</sub> have to be set to low, and R<sub>8</sub> has to be set high.

Note 2:  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  configuration modes C<sub>6</sub>, C<sub>5</sub>, C<sub>4</sub> = 000, 001, 010, 100 and 111 are reserved.

# 9.0 DRAM Critical Timing Parameters

The two critical timing parameters, shown in *Figure 39*, that must be met when controlling the access timing to a DRAM are the row address hold time, tRAH, and the column address setup time, tASC. Since the NS32CG821A contains a precise internal delay line, the values of these parameters can be selected at programming time. These values will also increase and decrease if DELCLK varies from 2 MHz.

## 9.1 PROGRAMMABLE VALUES OF tRAH AND tASC

The NS32CG821A allow the values of tRAH and tASC to be selected at programming time. For each parameter, two choices can be selected. tRAH, the row address hold time, is measured from RAS asserted to the row address starting to change to the column address. The two choices for tRAH are 15 ns and 25 ns, programmable through address bit C8.

tASC, the column address setup time, is measured from the column address valid to  $\overline{CAS}$  asserted. The two choices for tASC are 0 ns and 10 ns, programmable through address bit C7.

# 9.2 CALCULATION OF tRAH AND tASC

There are two clock inputs to the NS32CG821A. These two clocks, DELCLK and CLK can either be tied together to the same clock or be tied to different clocks running asynchronously at different frequencies.

The clock input, DELCLK, controls the internal delay line and refresh request clock. DELCLK should be a multiple of 2 MHz. If DELCLK is not a multiple of 2 MHz, tRAH and tASC will change. The new values of tRAH and tASC can be calculated by the following formulas:

If tRAH was programmed to equal 15 ns then tRAH =  $30^{*}(((DELCLK Divisor)^{*} 2 MHz/(DELCLK Frequency))-1) + 15 ns.$ 

If tRAH was programmed to equal 25 ns then tRAH = 30\*(((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency))-1) + 25 ns.

If tASC was programmed to equal 0 ns then tASC = 15\* ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 15 ns. If tASC was programmed to equal 10 ns then tASC = 25\* ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 15 ns. Since the values of tRAH and tASC are increased or decreased, the time to  $\overline{\text{CAS}}$  asserted will also increase or decrease. These parameters can be adjusted by the following formula:

Delay to  $\overline{CAS}$  = Actual Spec. + Actual tRAH – Programmed tRAH + Actual tASC – Programmed tASC.

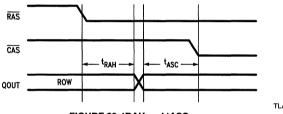


FIGURE 39. tRAH and tASC

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# 10.0 Absolute Maximum Ratings (Note 1)

All Input or Output Voltage with Respect to GND......-0.5V to +7V Power Dissipation @ 20 MHz.....0.5W ESD Rating to be determined.

| Symbol            | Parameter                 | Conditions                                                                      | Min                   | Тур | Max                   | Units |
|-------------------|---------------------------|---------------------------------------------------------------------------------|-----------------------|-----|-----------------------|-------|
| V <sub>IH</sub>   | Logical 1 Input Voltage   | Tested with a Limited<br>Functional Pattern                                     | 2.0                   |     | V <sub>CC</sub> + 0.5 | v     |
| V <sub>IL</sub>   | Logical 0 Input Voltage   | Tested with a Limited<br>Functional Pattern                                     | -0.5                  |     | 0.8                   | v     |
| V <sub>OH1</sub>  | Q and WE Outputs          | $I_{OH} = -10 \text{ mA}$                                                       | V <sub>CC</sub> - 1.0 |     |                       | v     |
| V <sub>OL1</sub>  | Q and WE Outputs          | l <sub>OL</sub> = 10 mA                                                         |                       |     | 0.5                   | v     |
| V <sub>OH2</sub>  | All Outputs except Qs, WE | $I_{OH} = -3 \text{ mA}$                                                        | V <sub>CC</sub> - 1.0 |     |                       | v     |
| V <sub>OL2</sub>  | All Outputs except Qs, WE | $I_{OL} = 3 \text{ mA}$                                                         |                       |     | 0.5                   | v     |
| I <sub>IN</sub>   | Input Leakage Current     | $V_{IN} = V_{CC} \text{ or } GND$                                               | -10                   |     | 10                    | μA    |
|                   | ML Input Current (Low)    | V <sub>IN</sub> = GND                                                           |                       |     | 200                   | μA    |
| I <sub>CC1</sub>  | Standby Current           | CLK at 8 MHz ( $V_{IN} = V_{CC}$ or GND)                                        |                       | 6   | 15                    | mA    |
| I <sub>CC1</sub>  | Standby Current           | CLK at 20 MHz (V <sub>IN</sub> = V <sub>CC</sub> or GND)                        |                       | 8   | 17                    | mA    |
| I <sub>CC1</sub>  | Standby Current           | CLK at 25 MHz (V <sub>IN</sub> = V <sub>CC</sub> or GND)                        |                       | 10  | 20                    | mA    |
| I <sub>CC2</sub>  | Supply Current            | CLK at 8 MHz (Inputs Active) $(I_{LOAD} = 0) (V_{IN} = V_{CC} \text{ or GND})$  |                       | 20  | 40                    | mA    |
| ICC2              | Supply Current            | CLK at 20 MHz (Inputs Active) $(I_{LOAD} = 0) (V_{IN} = V_{CC} \text{ or GND})$ |                       | 40  | 75                    | mA    |
| ICC2              | Supply Current            | CLK at 25 MHz (Inputs Active)<br>( $I_{LOAD} = 0$ ) ( $V_{IN} = V_{CC}$ or GND) |                       | 50  | 95                    | mA    |
| C <sub>IN</sub> * | Input Capacitance         | f <sub>IN</sub> at 1 MHz                                                        |                       |     | 10                    | pF    |

# **11.0 DC Electrical Characteristics** $T_A = 0^{\circ}C$ to $+70^{\circ}C$ , $V_{CC} = 5V \pm 10\%$ , GND = 0V

\*Note: CIN is not 100% tested.

# 12.0 AC Timing Parameters: NS32CG821A

Two speed selections are given, the NS32CG821A-20 and the NS32CG821A-25. The differences between the two parts are the maximum operating frequencies of the input CLKs and the maximum delay specifications. Low frequency applications may use the "-25" part to gain improved timing.

The AC timing parameters are grouped into sectional numbers as shown below. These numbers also refer to the timing diagrams.

1-36 Common parameters to all modes of operation

50–56 Difference parameters used to calculate; RAS low time.

RAS precharge time.

- CAS high time and
- CAS low time

200-212 Refresh parameters

- 300-315 Memory access parameters used in both single and dual access applications
- 500-506 Programming parameters

Unless otherwise stated V<sub>CC</sub> = 5.0V  $\pm$ 10%, 0 < T<sub>A</sub> < 70°C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except
- $C_{L} = 150 \text{ pF}$  loads on Q0-9 and  $\overline{WE}$ ; or
- C<sub>H</sub> = 50 pF loads on all outputs except

$$C_{H} = 125 \text{ pF}$$
 loads on  $\overline{RAS0}$  - 3 and  $\overline{CAS0}$  - 3 and

 $C_H = 380 \text{ pF}$  loads on Q0-9 and  $\overline{WE}$ .

**12.0 AC Timing Parameters: NS32CG821A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_L = 150 \text{ pF}$  loads on Q0-9 and WE; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0–3 and CAS0–3 and  $C_H=380$  pF loads on Q0–9 and WE.

|        |                 |                                                                                                       |     | NS32CG | 821A-2 | 0   | NS32CG821A-25 |     |     |     |  |
|--------|-----------------|-------------------------------------------------------------------------------------------------------|-----|--------|--------|-----|---------------|-----|-----|-----|--|
| Number | Symbol          | Common Parameter<br>Description                                                                       |     | CL     | c      | Я   |               | CL  | C   | н   |  |
|        |                 | Description                                                                                           | Min | Max    | Min    | Max | Min           | Max | Min | Max |  |
| 1      | fCLK            | CLK Frequency                                                                                         | 0   | 20     | 0      | 20  | 0             | 25  | 0   | 25  |  |
| 2      | tCLKP           | CLK Period                                                                                            | 50  |        | 50     |     | 40            |     | 40  |     |  |
| 3, 4   | tCLKPW          | CLK Pulse Width                                                                                       | 15  |        | 15     |     | 12            |     | 12  |     |  |
| 5      | fDCLK           | DELCLK Frequency                                                                                      | 5   | 20     | 5      | 20  | 5             | 20  | 5   | 20  |  |
| 6      | tDCLKP          | DELCLK Period                                                                                         | 50  | 200    | 50     | 200 | 50            | 200 | 50  | 200 |  |
| 7, 8   | tDCLKPW         | DELCLK Pulse Width                                                                                    | 15  |        | 15     |     | 12            |     | 12  |     |  |
| 9a     | tPRASCAS0       | $\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)                 | 30  |        | 30     |     | 30            |     | 30  |     |  |
| 9b     | tPRASCAS1       | $\overrightarrow{RAS}$ Asserted to $\overrightarrow{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)    | 40  |        | 40     |     | 40            |     | 40  |     |  |
| 9c     | tPRASCAS2       | ( $\overline{\text{RAS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns) | 40  |        | 40     |     | 40            |     | 40  |     |  |
| 9d     | tPRASCAS3       | ( $\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)              | 50  |        | 50     |     | 50            |     | 50  |     |  |
| 10a    | tRAH            | Row Address Hold Time (tRAH = 15)                                                                     | 15  |        | 15     |     | 15            |     | 15  |     |  |
| 10b    | tRAH            | Row Address Hold Time (tRAH = $25$ )                                                                  | 25  |        | 25     |     | 25            |     | 25  |     |  |
| 11a    | tASC            | Column Address Setup Time (tASC $=$ 0)                                                                | 0   |        | 0      |     | 0             |     | 0   |     |  |
| 11b    | tASC            | Column Address Setup Time (tASC = 10)                                                                 | 10  |        | 10     |     | 10            |     | 10  |     |  |
| 12     | tPCKRAS         | CLK High to RAS Asserted following Precharge                                                          |     | 27     |        | 32  |               | 22  |     | 26  |  |
| 13     | <b>tPARQRAS</b> | TSO Negated to RAS Negated                                                                            |     | 38     |        | 43  |               | 31  |     | 35  |  |
| 14     | tPENCL          | ECAS0-3 Asserted to CAS Asserted                                                                      |     | 23     |        | 31  |               | 20  |     | 27  |  |
| 15     | tPENCH          | ECAS0-3 Negated to CAS Negated                                                                        |     | 25     |        | 33  |               | 20  |     | 27  |  |
| 16     | <b>tPARQCAS</b> | TSO Negated to CAS Negated                                                                            |     | 60     |        | 68  |               | 47  |     | 54  |  |
| 17     | tPCLKWH         | CLK to WAIT Negated                                                                                   |     | 39     |        | 39  |               | 24  |     | 31  |  |
| 19     | tPEWL           | ECAS Negated to WAIT Asserted<br>during a Burst Access                                                |     | 44     |        | 44  |               | 36  |     | 36  |  |
| 20     | tSECK           | ECAS Asserted Setup to CLK High to<br>Recognize the Rising Edge of CLK<br>during a Burst Access       | 24  |        | 24     |     | 19            |     | 19  |     |  |
| 23     | tSWCK           | WAITIN Asserted Setup to CLK                                                                          | 5   |        | 5      |     | 5             |     | 5   |     |  |
| 24     | tPWINWEH        | WIN Asserted to WE Asserted                                                                           |     | 34     |        | 44  |               | 27  |     | 37  |  |
| 25     | tPWINWEL        | WIN Negated to WE Negated                                                                             |     | 34     |        | 44  |               | 27  |     | 37  |  |
| 26     | tPAQ            | Row, Column Address Valid to Q0–9 Valid                                                               |     | 29     |        | 38  |               | 26  |     | 35  |  |
| 27     | tPCINCQ         | COLINC Asserted to Q0-9<br>Incremented                                                                |     | 34     |        | 43  |               | 30  |     | 39  |  |
| 28     | tSCINEN         | COLINC Asserted Setup to $\overline{\text{ECAS}}$<br>Asserted to Ensure tASC = 0 ns                   | 18  |        | 19     |     | 17            |     | 19  |     |  |

**12.0 AC Timing Parameters: NS32CG821A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C  $< T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-9 and  $\overline{\text{WE}}$ ; or

|        |          |                                                                                           |     | NS32CG | 821A-2 | 0              |     | NS32CG | 821A-2 | 5   |
|--------|----------|-------------------------------------------------------------------------------------------|-----|--------|--------|----------------|-----|--------|--------|-----|
| Number | Symbol   | Common Parameter                                                                          |     | CL     |        | C <sub>H</sub> |     | CL     |        | й   |
|        |          | Description                                                                               | Min | Max    | Min    | Max            | Min | Max    | Min    | Max |
| 29a    | tSARQCK1 | TSO Negated Setup to CLK<br>High with 1 Period of Precharge                               | 46  |        | 46     |                | 37  |        | 37     |     |
| 29b    | tSARQCK2 | TSO Negated Setup to CLK High with<br>> 1 Period of Precharge Programmed                  | 19  |        | 19     |                | 15  |        | 15     |     |
| 31     | tPCKCAS  | CLK High to CAS Asserted when Delayed by WIN                                              |     | 31     |        | 39             |     | 25     |        | 32  |
| 32     | tSCADEN  | Column Address Setup to $\overline{\text{ECAS}}$<br>Asserted to Guarantee tASC = 0        | 14  |        | 15     |                | 14  |        | 16     |     |
| 33     | tWCINC   | COLINC Pulse Width                                                                        | 20  |        | 20     |                | 20  |        | 20     |     |
| 34a    | tPCKCL0  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 15 ns, tASC = 0 ns)  |     | 81     |        | 89             |     | 72     |        | 79  |
| 34b    | tPCKCL1  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 15 ns, tASC = 10 ns) |     | 91     |        | 99             |     | 82     |        | 89  |
| 34c    | tPCKCL2  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 0 ns)  |     | 91     |        | 99             |     | 82     |        | 89  |
| 34d    | tPCKCL3  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 10 ns) |     | 101    |        | 109            |     | 92     |        | 99  |
| 35     | tCAH     | Column Address Hold Time<br>(Interleave Mode Only)                                        | 32  |        | 32     |                | 32  |        | 32     |     |
| 36     | tPCQR    | CAS Asserted to Row Address<br>Valid (Interleave Mode Only)                               |     | 90     |        | 90             |     | 90     |        | 90  |

NS32CG821A

**12.0 AC Timing Parameters: NS32CG821A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-9 and  $\overline{\text{WE}}$ ; or

 $\begin{array}{l} C_{H}=50 \text{ pF loads on all outputs except} \\ C_{H}=125 \text{ pF loads on } \overline{RAS0-3} \text{ and } \overline{CAS0-3} \text{ and} \\ C_{H}=380 \text{ pF loads on } Q0-9 \text{ and } \overline{WE}. \end{array}$ 

|               |      |                                                                        |     | NS32CG | 821A-20        | )   |     | NS32CG | 821A-25        |     |
|---------------|------|------------------------------------------------------------------------|-----|--------|----------------|-----|-----|--------|----------------|-----|
| Number Symbol |      | Difference Parameter<br>Description                                    | CL  |        | C <sub>H</sub> |     | CL  |        | С <sub>Н</sub> |     |
|               |      | Description                                                            | Min | Max    | Min            | Max | Min | Max    | Min            | Max |
| 50            | tD1  | (TSO Negated to RAS<br>Negated) Minus (CLK High to RAS<br>Asserted)    |     | 16     |                | 16  |     | 14     |                | 14  |
| 51            | tD2  | (CLK High to Refresh RAS Negated)<br>Minus (CLK High to RAS Asserted)  |     | 13     |                | 13  |     | 11     |                | 11  |
| 53            | tD3b | (CLK High to RAS Asserted<br>Minus (TSO Negated to RAS Negated)        |     | 4      |                | 4   |     | 4      |                | 4   |
| 54            | tD4  | (ECAS Asserted to CAS Asserted)<br>Minus (ECAS Negated to CAS Negated) | -7  | 7      | -7             | 7   | -7  | 7      | -7             | 7   |
| 55            | tD5  | (CLK to Refresh RAS Asserted) Minus<br>(CLK to Refresh RAS Negated)    |     | 6      |                | 6   |     | 6      |                | 6   |

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C  $< T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except
- $C_{L} = 150 \text{ pF}$  loads on Q0-9 and  $\overline{WE}$ ; or

 $C_H = 50 \text{ pF}$  loads on all outputs except

 $C_{H}$  = 125 pF loads on  $\overline{RAS}0\text{--}3$  and  $\overline{CAS}0\text{--}3$  and

 $C_{H} = 380 \text{ pF}$  loads on Q0-9 and  $\overline{WE}$ .

|        |                   |                                  |     | NS32CG | 821A-20        | )   | NS32CG821A-25 |     |     |     |
|--------|-------------------|----------------------------------|-----|--------|----------------|-----|---------------|-----|-----|-----|
| Number | lumber Symbol     | Refresh Parameter<br>Description | CL  |        | C <sub>H</sub> |     | CL            |     | C   | н   |
|        |                   | Description                      | Min | Max    | Min            | Max | Min           | Max | Min | Max |
| 207    | <b>tPCKRFRASH</b> | CLK High to Refresh RAS Negated  |     | 35     |                | 40  |               | 29  |     | 33  |
| 208    | tPCKRFRASL        | CLK High to Refresh RAS Asserted |     | 28     |                | 33  |               | 23  |     | 27  |

**12.0 AC Timing Parameters: NS32CG821A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-9 and  $\overline{\text{WE}}$ ; or

 $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0-3 and CAS0-3 and  $C_H=380$  pF loads on Q0-9 and WE.

|        |           |                                                                                                                                     |     | NS32CG | 821A-2 | ס   | NS32CG821A-25 |     |     |     |  |
|--------|-----------|-------------------------------------------------------------------------------------------------------------------------------------|-----|--------|--------|-----|---------------|-----|-----|-----|--|
| Number | Symbol    | Memory Access Parameter Description                                                                                                 | (   | CL     | C      | Я   | (             | CL  | c   | н   |  |
|        |           | Parameter Description                                                                                                               | Min | Max    | Min    | Max | Min           | Max | Min | Max |  |
| 300    | tSCSCK    | CS Asserted to CLK High                                                                                                             | 14  |        | 14     |     | 13            |     | 13  |     |  |
| 301a   | tSALECKNL | ALE Asserted Setup to CLK High<br>Not Using On-Chip Latches or<br>if Using On-Chip Latches and<br>B0, B1, Are Constant, Only 1 Bank | 16  |        | 16     |     | 15            |     | 15  |     |  |
| 301b   | tSALECKL  | ALE Asserted Setup to CLK High,<br>if Using On-Chip Latches if B0, B1<br>Can Change, More Than One Bank                             | 29  |        | 29     |     | 29            |     | 29  |     |  |
| 302    | tWALE     | ALE Pulse Width                                                                                                                     | 18  |        | 18     |     | 13            |     | 13  |     |  |
| 303    | tSBADDCK  | Bank Address Valid Setup to CLK High                                                                                                | 20  |        | 20     |     | 18            |     | 18  |     |  |
| 304    | tSADDCK   | Row, Column Valid Setup to<br>CLK High to Guarantee<br>tASR = 0 ns                                                                  | 11  |        | 15     |     | 11            |     | 16  |     |  |
| 305    | tHASRCB   | Row, Column, Bank Address<br>Held from ALE Negated<br>(Using On-Chip Latches)                                                       | 10  |        | 10     |     | 8             |     | 8   |     |  |
| 306    | tSRCBAS   | Row, Column, Bank Address<br>Setup to ALE Negated<br>(Using On-Chip Latches)                                                        | 3   |        | 3      |     | 2             |     | 2   |     |  |
| 307    | tPCKRL    | CLK High to RAS Asserted                                                                                                            |     | 27     |        | 32  |               | 22  |     | 26  |  |
| 308a   | tPCKCL0   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)                                                                |     | 81     |        | 89  |               | 72  |     | 79  |  |
| 308b   | tPCKCL1   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)                                                               |     | 91     |        | 99  |               | 82  |     | 89  |  |
| 308c   | tPCKCL2   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)                                                                |     | 91     |        | 99  |               | 82  |     | 89  |  |
| 308d   | tPCKCL3   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)                                                               |     | 101    |        | 109 |               | 92  |     | 99  |  |
| 309    | tHCKALE   | ALE Negated Hold from CLK High                                                                                                      | 0   |        | 0      |     | 0             |     | 0   |     |  |
| 310    | tSWINCK   | WIN Asserted Setup to CLK High that starts access RAS to Guarantee CAS is Delayed                                                   | -21 |        | -21    |     | - 16          |     | -16 |     |  |
| 311    | tPCSWL    | CS Asserted to WAIT Asserted                                                                                                        |     | 26     |        | 26  |               | 22  |     | 22  |  |
| 312    | tPCSWH    | CS Negated to WAIT Negated                                                                                                          |     | 30     |        | 30  |               | 25  |     | 25  |  |
| 314    | tPALEWL   | ALE Asserted to WAIT Asserted<br>(CS is Already Asserted)                                                                           |     | 35     |        | 35  |               | 29  |     | 29  |  |
| 315    |           | $\overline{\text{TSO}}$ Negated to CLK High That Starts<br>Access $\overline{\text{RAS}}$ to Guarantee tASR = 0 ns                  | 41  |        | 45     |     | 34            |     | 39  |     |  |
| 316    | ttPCKCV0  | CLK to Column Addr. Valid<br>( $t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns}$ )                                                  |     | 78     |        | 87  |               | 60  |     | 75  |  |

**12.0 AC Timing Parameters: NS32CG821A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 DRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

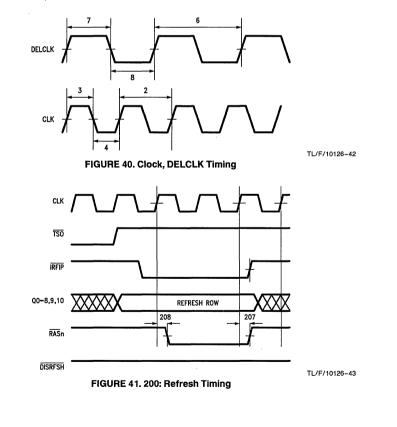
- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-9 and  $\overline{\text{WE}}$ ; or

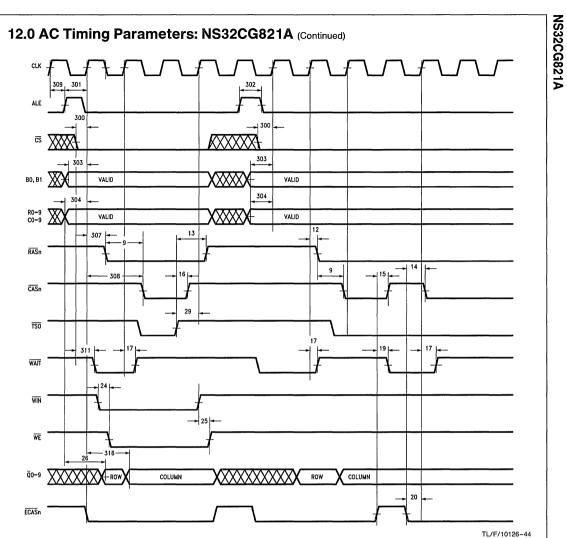
- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0–3 and CAS0–3 and  $C_H=380$  pF loads on Q0–9 and  $\overline{WE}.$

|        |          |                                                 |     | NS32CG | 821A-2 | 0   | NS32CG821A-25 |     |    |   |
|--------|----------|-------------------------------------------------|-----|--------|--------|-----|---------------|-----|----|---|
| Number | Symbol   | Programming<br>Parameter Description<br>Min Max | CL  |        | C      | н   | CL            |     | С  | н |
|        |          |                                                 | Min | Max    | Min    | Max | Min           | Max |    |   |
| 500    | tHMLADD  | Mode Address Held from ML Negated               | 8   |        | 8      |     | 7             |     | 7  |   |
| 501    | tSADDML  | Mode Address Setup to ML Negated                | 6   |        | 6      |     | 6             |     | 6  |   |
| 502    | tWML     | ML Pulse Width                                  | 15  |        | 15     |     | 15            |     | 15 |   |
| 503    | tSADAQML | Mode Address Setup to TSO Asserted              | 0   |        | 0      |     | 0             |     | 0  |   |
| 504    | tHADAQML | Mode Address Held from TSO Asserted             | 51  |        | 51     |     | 38            |     | 38 |   |
| 505    | tSCSARQ  | CS Asserted Setup to<br>TSO Asserted            | 6   |        | 6      |     | 6             |     | 6  |   |
| 506    | tSMLARQ  | ML Asserted Setup to TSO Asserted               | 10  |        | 10     |     | 10            |     | 10 |   |

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Input pulse 0V to 3V; tR = tF = 2.5 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.4V for High and 0.8V for Low. Note 3: AC Production testing is done at 50 pF.

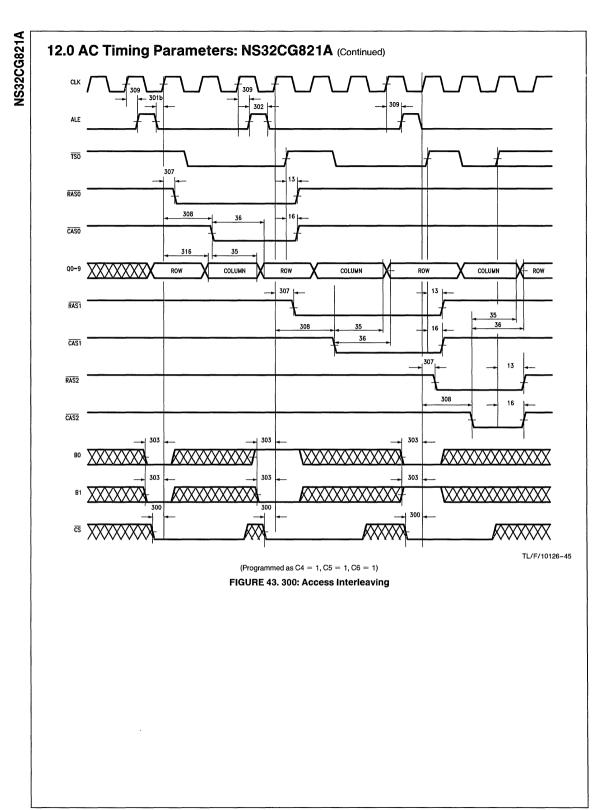


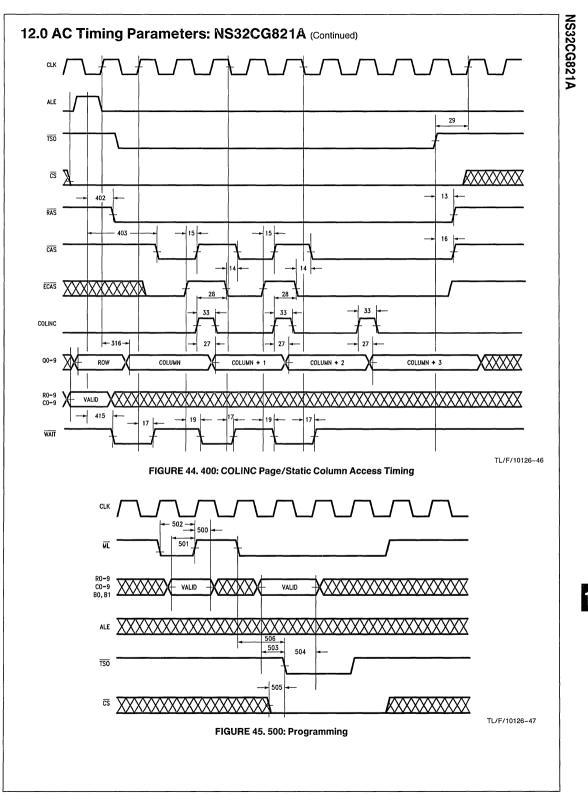


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FIGURE 42. 300: Memory Access Timing

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# 13.0 Timing Differences Between the NS32CG821A and the NS32CG821

The only differences between the NS32CG821A and the NS32CG821 are AC timing. The 4 tables below list the differences.

|        |                       | Common Parameter                                                                     |       | NS   | 32CG  | 821-25 |                |     | NS32CG     | 821A-25 | 5   |
|--------|-----------------------|--------------------------------------------------------------------------------------|-------|------|-------|--------|----------------|-----|------------|---------|-----|
| Number | Symbol                | Description                                                                          |       | CL   |       | (      | Сн             |     | C          | C       | н   |
|        |                       | -                                                                                    | Min   | M    | ax    | Min    | Max            | Min | Max        | Min     | Max |
| 10a    | t <sub>RAH</sub>      | Row Address Hold<br>Time (t <sub>RAH</sub> = 15)                                     | 17    |      |       | 15     |                | 15  |            | 15      |     |
| 10b    | t <sub>RAH</sub>      | Row Address Hold<br>Time (t <sub>RAH</sub> = 25)                                     | 27    |      |       | 25     |                | 25  |            | 25      |     |
| 11a    | tASC                  | Column Address Setup<br>Time ( $t_{ASC} = 0$ )                                       | 2     |      |       | 0      |                | 0   |            | 0       |     |
| 11b    | tASC                  | Column Address Setup<br>Time ( $t_{ASC} = 10$ )                                      | 12    |      |       | 10     |                | 10  |            | 10      |     |
| 17     | <sup>t</sup> PCLKWH   | CLK to WAIT Negated                                                                  |       | 3    | 9     |        | 39             |     | 24         |         | 31  |
| 19     | t <sub>PEWL</sub>     | ECAS Negated to WAIT<br>Asserted During a Burst Access                               |       | 3    | 4     |        | 34             |     | 36         |         | 36  |
| 24     | <b>t</b> PWINWEH      | WIN Asserted to WE Asserted                                                          |       | 3    | 4     |        | 44             |     | 27         |         | 37  |
| 25     | twinwel               | WIN Negated to WE Negated                                                            |       | 3    | 1     |        | 41             |     | 27         |         | 37  |
| 28     | tSCINEN               | COLINC Asserted to Q0-9<br>Incremented                                               | 15    |      |       | 17     |                | 17  |            | 19      |     |
| 29a    | <sup>t</sup> SARQCK1  | TSO Negated Setup to CLK<br>High with 1 Period of Precharge                          | 34    |      |       | 34     |                | 37  |            | 37      |     |
|        |                       |                                                                                      | TABLE | 11   |       |        |                |     |            |         |     |
|        |                       | Difference Developmenter                                                             |       | N    | 15320 | G821-  | 25             |     | NS32C      | G821A-2 | 5   |
| Number | Symbol                | Difference Parameter<br>Description                                                  |       | CL   |       |        | С <sub>Н</sub> | CL  |            |         | CH  |
|        |                       |                                                                                      | Ν     | /lin | Max   | Mir    | Max            | Min | Max        | Min     | Max |
| 55     | t <sub>D5</sub>       | (CLK to Refresh RAS Asserted)<br>Minus (CLK to Refresh RAS Negate                    | ed)   |      | 5     |        | 5              |     | 6          |         | 6   |
|        | , 4                   | •                                                                                    | TABLE |      |       |        |                |     | - <b>I</b> |         | -   |
|        |                       |                                                                                      |       | NS   | 2CG   | 821-25 |                |     | NS32CG     | 821A-25 | 5   |
| Number | Symbol                | Memory Access<br>Parameter Description                                               |       | CL   |       | c      | Я              | (   |            | C       | Эн  |
|        |                       |                                                                                      | Min   | Ma   | IX    | Min    | Max            | Min | Max        | Min     | Max |
| 312    | t <sub>PCSWL</sub>    | CS Negated to WAIT Negated                                                           |       | 2    | 2     |        | 22             |     | 25         |         | 25  |
| 314    | <sup>t</sup> PALEWL   | ALE Asserted to WAIT Asserted<br>(CS is Already Asserted)                            |       | 3!   | Э     |        | 39             |     | 29         |         | 29  |
| 316    | <sup>t</sup> PCKCVO   | CLK to Column Address Valid<br>( $t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns}$ ) |       | 6    | 3     |        | 75             |     | 60         |         | 75  |
|        | L                     |                                                                                      | TABLE | IV   |       |        |                |     | I          | L       |     |
|        |                       | Due anno 1997 De mars de m                                                           |       | NS32 | CG82  | 1-25   |                |     | NS32CG     | 821A-25 |     |
| Number | Programming Parameter |                                                                                      |       | С    | L     | c      | н              |     |            |         |     |
|        |                       |                                                                                      | Min   | Max  | N     | /lin   | Max            | Min | Max        | Min     | Max |
| 500    | tHMLADD               | Mode Address Held<br>from ML Negated                                                 | 5     |      |       | 5      |                | 7   |            | 7       |     |
| 504    | t <sub>HADAQML</sub>  | Mode Address Held                                                                    | 29    |      |       | 29     |                | 38  |            | 38      |     |

# 14.0 NS32CG821A User Hints

1. All inputs to the NS32CG821A should be tied high, low or the output of some other device.

Note: One signal is active high. COLINC should be tied low to disable.

- 2. Each ground on the NS32CG821A must be decoupled to the closest on-chip supply (V<sub>CC</sub>) with 0.1  $\mu$ F ceramic capacitor. This is necessary because these grounds are kept separate inside the NS32CG821A. The decoupling capacitors should be placed as close as possible with short leads to the ground and supply pins of the NS32CG821A.
- 3. The output called "CAP" should have a 0.1  $\mu \text{F}$  capacitor to ground.
- 4. The NS32CG821A has  $20\Omega$  series damping resistors built into the output drivers of RAS, CAS, address and WE. Space should be provided for external damping resistors on the printed circuit board (or wire-wrap board) because they may be needed. The value of these damping resistors (if needed) will vary depending upon the output, the capacitance of the load, and the characteristics of the trace as well as the routing of the trace. The value of the damping resistor also may vary between the wire-wrap board and the printed circuit board. To determine the value of the series damping resistor it is recommended to use an oscilloscope and look at the furthest DRAM from the NS32CG821A. The undershoot of RAS, CAS, WE and the addresses should be kept to less than 0.5V below ground by varying the value of the damping resistor. The damping resistors should be placed as close as possible with short leads to the driver outputs of the NS32CG821A.
- 5. The circuit board must have a good V<sub>CC</sub> and ground plane connection. If the board is wire-wrapped, the V<sub>CC</sub> and ground pins of the NS32CG821A, the DRAM associated logic and buffer circuitry must be soldered to the V<sub>CC</sub> and ground planes.
- 6. The traces from the NS32CG821A to the DRAM should be as short as possible.

 ECAS0 should be held low during programming if the user wishes that the NS32CG821A be compatible with NSCG821 design.

#### 8. PARAMETER CHANGES DUE TO LOADING

All A.C. parameters are specified with the equivalent load capacitances, including traces, of 64 DRAMs organized as 4 banks of 18 DRAMs each. Maximums are based on worst-case conditions. If an output load changes then the A.C. timing parameters associated with that particular output must be changed. For example, if we changed our output load to

C = 250 pF loads on  $\overline{RAS}0-3$  and  $\overline{CAS}0-3$ 

C = 760 pF loads on Q0–9 and  $\overline{WE}$ 

we would have to modify some parameters (not all calculated here)

\$308a Clock to CAS asserted

 $(t_{RAH} = 15 \text{ ns}, t_{ASC} = 0 \text{ ns})$ 

A ratio can be used to figure out the timing change per change in capacitance for a particular parameter by using the specifications and capacitances from heavy and light load timing.

$$\begin{aligned} \text{Ratio} &= \frac{\$308\text{a w/heavy load} - \$308\text{a w/light load}}{C_{\text{H}}(\overline{\text{CAS}}) - C_{\text{L}}(\overline{\text{CAS}})} \\ &= \frac{79 \text{ ns} - 72 \text{ ns}}{125 \text{ pF} - 50 \text{ pF}} = \frac{7 \text{ ns}}{75 \text{ pF}} \end{aligned}$$

\$308a (actual) = (capacitance difference imes

ratio) + \$308a (specified)

$$= \left(250 \text{ pF} - 125 \text{ pF}\right) \frac{7 \text{ ns}}{75 \text{ pF}} + 79 \text{ ns}$$
$$= 11.7 \text{ ns} + 79 \text{ ns}$$

 It is recommended that the user perform an external hardware reset of the NSCG821A before programming and using the chip. A hardware reset consists of asserting both ML and DISRFSH for a minimum of 16 positive edges of CLK.



# PRELIMINARY

# DP8520A/DP8521A/DP8522A microCMOS Programmable 256k/1M/4M Video RAM Controller/Drivers

# **General Description**

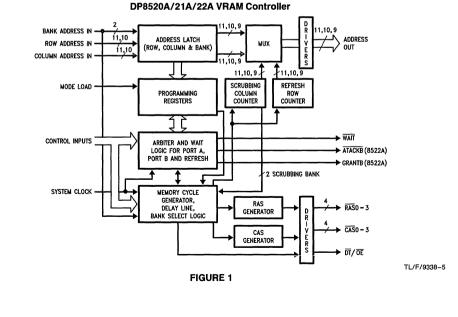
The DP8520A/21A/22A video RAM controllers provide a low cost, single chip interface between video RAM and all 8-, 16- and 32-bit systems. The DP8520A/21A/22A generate all the required access control signal timing for VRAMs. An on-chip refresh request clock is used to automatically refresh the VRAM array. Refreshes and accesses are arbitrated on chip. If necessary, a WAIT or DTACK output inserts wait states into system access cycles, including burst mode accesses, RAS low time during refreshes and RAS precharge time after refreshes and back to back accesses are guaranteed through the insertion of wait states. Separate on-chip precharge counters for each RAS output can be used for memory interleaving to avoid delayed back to back accesses because of precharge. An additional feature of the DP8522A is two access ports to simplify dual accessing. Arbitration among these ports and refresh is done on chip.

# **Features**

- On chip high precision delay line to guarantee critical VRAM access timing parameters
- microCMOS process for low power
- High capacitance drivers for RAS, CAS, DT/OE and VRAM address on chip
- On chip support for nibble, page and static column VRAMs
- Byte enable signals on chip allow byte writing in a word size up to 16 bits with no external logic
- Selection of controller speeds: 20 MHz and 25 MHz
- On board Port A/Port B (DP8522A only)/refresh arbitration logic
- Direct interface to all major microprocessors (application notes available)
- 4 RAS and 4 CAS drivers (the RAS and CAS configuration is programmable)

| Control | # of Pins<br>(PLCC) | # of Address<br>Outputs | Largest<br>VRAM<br>Possible | Direct Drive<br>Memory<br>Capacity | Access<br>Ports<br>Available |
|---------|---------------------|-------------------------|-----------------------------|------------------------------------|------------------------------|
| DP8520A | 68                  | 9                       | 256 kbit                    | 4 Mbytes                           | Single Access Port           |
| DP8521A | 68                  | 10                      | 1 Mbit                      | 16 Mbytes                          | Single Access Port           |
| DP8522A | 84                  | 11                      | 4 Mbit                      | 64 Mbytes                          | Dual Access Ports (A and B)  |

# **Block Diagram**



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# 1.0 Introduction

The DP8520A/21A/22A are CMOS Video RAM controllers that incorporate many advanced features including the capabilities of address latches, refresh counter, refresh clock, row, column and refresh address multiplexor, delay line, refresh/access/VRAM transfer cycle arbitration logic and high capacitive drivers. The programmable system interface allows any manufacturer's microprocessor or bus to directly interface via the DP8520A/21A/22A to VRAM arrays up to 64 Mbytes in size.

After power up, the DP8520A/21A/22A must first be programmed before accessing the VRAM. The chip is programmed through the address bus.

There are two methods of programming the chip. The first method, mode load only, is accomplished by asserting the signal mode load,  $\overline{ML}$ . A valid programming selection is presented on the row, column, bank and  $\overline{ECAS}$  inputs, then  $\overline{ML}$  is negated. When  $\overline{ML}$  is negated, the chip is programmed with the valid programming bits on the address bus.

The second method, chip selected access, is accomplished by asserting  $\overline{ML}$  and performing a chip selected access. When  $\overline{CS}$  and  $\overline{AREQ}$  are asserted for the access, the chip is programmed. During this programming access, the programming bits affecting the wait logic become effective immediately, allowing the access to terminate. After the access, take effect.

Once the DP8520A/21A/22A has been programmed, a 60 ms initialization period is entered. During this time, the DP8520A/21A/22A controllers perform refreshes to the VRAM array so further VRAM warm up cycles are unnecessary.

The DP8520A/21A/22A can now be used to access the VRAM. There are two modes of accessing with the controller. The two modes are Mode 0, which initiates  $\overline{RAS}$  synchronously, and Mode 1, which initiates  $\overline{RAS}$  asynchronously.

To access the VRAM using Mode 0, the signal ALE is asserted along with  $\overline{CS}$  to ensure a valid VRAM access. ALE asserting sets an internal latch and only needs to be pulsed and not held throughout the entire access. On the next rising clock edge, after the latch is set, RAS will be asserted for that access. The DP8520A/21A/22A will place the row address on the VRAM address bus, guarantee the programmed value of row address hold time of the VRAM, place the column address on the VRAM address bus, guarantee the programmed value of column address setup time and assert  $\overline{CAS}$ . AREQ can be asserted anytime after the clock edge which starts the access RAS. RAS and  $\overline{CAS}$  will extend until  $\overline{AREQ}$  is negated.

The other access mode, Mode 1, is asynchronous to the clock. When  $\overline{\text{ADS}}$  is asserted,  $\overline{\text{RAS}}$  is asserted. The DP8520A/21A/22A will place the row address on the VRAM address bus, guarantee the programmed value of row address hold time, place the column address on the VRAM address bus, guarantee the programmed value of column address setup time and assert CAS. AREQ can be tied to  $\overline{\text{ADS}}$  or can be asserted after  $\overline{\text{ADS}}$  is asserted. AREQ negated will terminate the access.

The DP8520A/21A/22A also provides full support for VRAM transfer cycles. To begin the cycle, the input AVSRLRQ, Advanced Video Shift Register Load Request, is

asserted and must precede the input VSRL. Video Shift Register Load, asserting by enough CLK periods to guarantee any access in progress or pending refresh can finish. VSRL asserting causes DT/OE to transition low immediately. Both  $\overline{\text{VSRL}}$  and  $\overline{\text{DT}}/\overline{\text{OE}}$  assert before  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  assert for the transfer. The cycle is ended by DT/OE negating. This is caused by either VSRL negating or by four rising edges of CLK from VSRL asserting, whichever comes first. The DP8520A/21A/22A have greatly expanded refresh capabilities compared to other VRAM controllers. There are three modes of refreshing available. These modes are internal automatic refreshing, externally controlled/burst refreshing, and refresh request/acknowledge refreshing. Any of these modes can be used together or separately to achieve the desired results. In any combination of these modes, the programming of ECAS0 determines the use of the RFIP (RFRQ) pin. ECAS0 asserted during programming causes this pin to function as RFIP which will assert just prior to a refresh cycle and will negate when the refresh is completed. ECAS0 negated during programming causes this pin to function as RFRQ which indicates an internal refresh request when asserted.

When using internal automatic refreshing, the DP8520A/ 21A/22A will generate an internal refresh request from the refresh request clock. The DP8520A/21A/22A will arbitrate between the refresh requests and accesses. Assuming an access is not currently in progress, the DP8520A/21A/22A will grant a refresh, assert  $\overrightarrow{\text{RFP}}$  if programmed, and on the next positive clock edge, refreshing will begin. If an access had been in progress, the refresh will begin after the access has terminated.

To use externally controlled/burst refresh, the user disables the internal refresh request by asserting the input DISRFRSH. A refresh can now be externally requested by asserting the input RFSH. The DP8520A/21A/22A will arbitrate between the external refresh request and accesses. Assuming an access is not currently in progress, the DP8520A/21A/22A will grant a refresh, assert RFIP if programmed, and on the next positive clock edge, refreshing will begin. If an access had been in progress, the refresh would take place after the access has terminated.

With refresh request/acknowledge mode, the DP8520A/ 21A/22A broadcasts the internal refresh request to the system through the RFRQ output pin. External circuitry can determine when to refresh the VRAM through the RFSH input.

The controllers have three types of refreshing available: conventional, staggered and error scrubbing. Any refresh control mode can be used with any type of refresh. In a conventional refresh, all of the  $\overline{\text{RAS}}$  outputs will be asserted and negated at once. In a staggered refresh, the  $\overline{\text{RAS}}$  outputs will be asserted one positive clock edge apart. Error scrubbing is the same as conventional refresh except that a  $\overline{\text{CAS}}$  will be asserted during a refresh allowing the system to run that data through an EDAC chip and write it back to memory, if a single bit error has occurred. The refreshes can be extended with the EXTEND REFRESH input, EXTNDRF.

The DP8520A/21A/22A have wait support available as DTACK or WAIT. Both are programmable. DTACK, Data Transfer ACKnowledge, is useful for processors whose wait signal is active high. WAIT is useful for processors whose

# 1.0 Introduction (Continued)

wait signal is active low. The user can choose either at programming. These signals are used by the on-chip arbitor to insert wait states to guarantee the arbitration between accesses and refreshes or precharge. Both signals are independent of the access mode chosen.

 $\overline{\text{DTACK}}$  will assert a programmed number of clock edges from the event that starts the access  $\overline{\text{RAS}}$ .  $\overline{\text{DTACK}}$  will be negated, when the access is terminated, by  $\overline{\text{AREQ}}$  being negated.  $\overline{\text{DTACK}}$  can also be programmed to toggle with the  $\overline{\text{ECAS}}$  inputs during burst/page mode accesses.

 $\label{eq:WAIT} \begin{array}{l} \hline WAIT \mbox{ is asserted during the start of the access (ALE and CS) or ADS and CS) and will negate a number of clock edges from the event that starts the access RAS. After WAIT is negated, it will stay negated until the next access. WAIT can also be programmed to toggle with ECAS inputs during a burst/page mode access. \\ \hline \end{array}$ 

Both signals can be dynamically delayed further through the WAITIN signal to the DP8520A/21A/22A.

The DP8520A/21A/22A have address latches, used to latch the bank, row and column address inputs. Once the address is latched, a column increment feature can be used to increment the column address. The address latches can also be programmed to be fall through.

The  $\overrightarrow{RAS}$  and  $\overrightarrow{CAS}$  drivers can be configured to drive a one, two or four bank memory array up to 32 bits in width. The two  $\overrightarrow{ECAS}$  signals can then be used to select one pair of  $\overrightarrow{CAS}$  drivers for byte writing with no external logic for systems with a word length of up to 16 bits.

When configuring the DP8520A/21A/22A for more than one bank, memory interleaving can be used. By tying the low order address bits to the bank select lines, B0 and B1, sequential back to back accesses will not be delayed since the DP8520A/21A/22A have separate precharge counters per bank. The DP8520A/21A/22A are capable of performing address pipelining. In address pipelining, the DP8520A/ 21A/22A guarantee the column address hold time and switch the internal multiplexor to place the row address on the address bus. At this time, another memory access to another bank can be initiated. The DP8522A has all the features previously mentioned. Unlike the DP8520A/21A, the DP8522A has a second port to allow a second CPU to access the memory array. This port, Port B, has two control signals to allow a CPU to access the VRAM array. These signals are access request for Port B, AREQB, and Advanced Transfer ACKnowledge for Port B. ATACKB. Two other signals are used by both Port A and Port B for dual accessing purposes. The signals are lock, LOCK and grant Port B, GRANTB, All arbitration for the two ports and refresh is done on-chip by the DP8522A through the insertion of wait states. Since the DP8522A has only one input address bus, the address lines have to be multiplexed externally. The signal GRANTB can be used for this purpose since it is asserted when Port B has access to the VRAM array and negated when Port A has access to the VRAM array. Once a port has access to the array, the other port can be "locked out" by asserting the input LOCK. AREQB, when asserted, is used by Port B to request an access. ATACKB, when asserted, signifies that access RAS has been asserted for the requested Port B access. By using ATACKB, the user can generate an appropriate WAIT or DTACK like signal for the Port B CPU.

The following explains the terminology used in this data sheet. The terms negated and asserted are used. Asserted refers to a "true" signal. Thus, "ECAS0 asserted" means the ECAS0 input is at a logic 0. The term "COLINC asserted" means the COLINC input is at a logic 1. The term negated refers to a "false" signal. Thus, "ECAS0 negated" means the ECAS0 input is at a logic 1. The term "COLINC negated" means the input COLINC input is at a logic 0. The table shown below clarifies this terminology.

| Signal      | Action   | Logic Level |
|-------------|----------|-------------|
| Active High | Asserted | High        |
| Active High | Negated  | Low         |
| Active Low  | Asserted | Low         |
| Active Low  | Negated  | High        |



# DP8520A/DP8521A/DP8522A

# **Connection Diagrams**

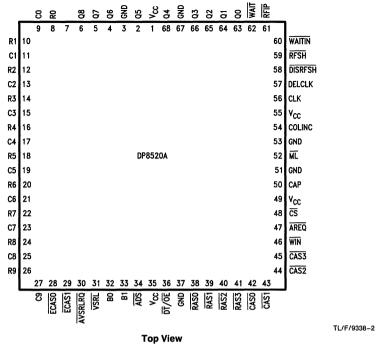
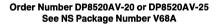
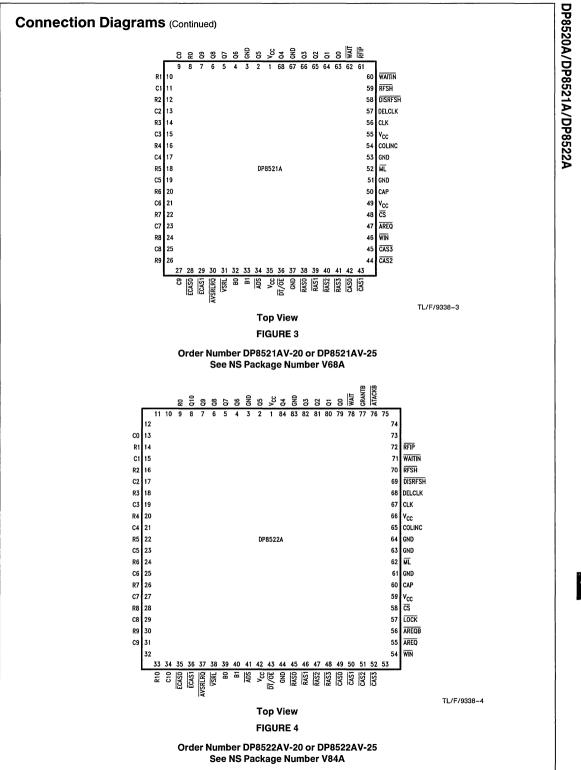


FIGURE 2





| Pin<br>Name           | Device (If not<br>applicable to all) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|-----------------------|--------------------------------------|------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.1 ADDRESS,          | R/W AND PROGRAM                      | MING SIG         | NALS                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| R0-10<br>R0-9         | DP8522A<br>DP8520A/21A               |                  | <b>ROW ADDRESS:</b> These inputs are used to specify the row address during an access or refresh to the VRAM or for a VRAM transfer cycle. They are also used to program the chip when $\overline{\text{ML}}$ is asserted (except R10).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| C0-10<br>C0-9         | DP8522A<br>DP8520A/21A               | l                | <b>COLUMN ADDRESS:</b> These inputs are used to specify the column address during an access to the VRAM or for a VRAM transfer cycle. They are also used to program the chip when $\overline{\text{ML}}$ is asserted (except C10).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| B0, B1                |                                      |                  | BANK SELECT: Depending on programming, these inputs are used to select a group of $\overrightarrow{RAS}$ and $\overrightarrow{CAS}$ outputs to assert during an access. They are also used to program the chip when $\overrightarrow{ML}$ is asserted.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| ECAS0-1               |                                      | 1                | <b>ENABLE CAS:</b> These inputs are used to enable a single or group of $\overline{CAS}$ outputs when asserted. In combination with the B0, B1 and the programming bits, these inputs select which $\overline{CAS}$ output or $\overline{CAS}$ outputs will assert during an access. ECAS0 must be asserted for either $\overline{CAS0}$ or $\overline{CAS1}$ to assert during an access. ECAS1 must be asserted for either $\overline{CAS0}$ or $\overline{CAS1}$ to assert during an access. The ECAS signals can also be used to toggle a group of $\overline{CAS}$ outputs for page/nibble mode accesses. They also can be used for byte write operations. If ECAS0 is negated during programming, continuing to assert the ECAS0 while negating $\overline{AREQ0}$ or $\overline{AREOB}$ during an access, will cause the $\overline{CAS0}$ outputs to be extended while the $\overline{RAS}$ outputs are negated (the $\overline{ECASn}$ inputs have no effect during scrubbing refreshes). |
| WIN                   |                                      | I                | WRITE ENABLE IN: This input is used to signify a write operation to the VRAM.<br>This input asserted will also cause CAS to delay to the next positive clock edge if<br>address bit C9 is asserted during programming.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| COLINC<br>(EXTNDRF)   |                                      | 1                | <b>COLUMN INCREMENT:</b> When the address latches are used, and a refresh is not in progress, this input functions as COLINC. Asserting this signal causes the column address to be incremented by one. When a refresh is in progress, this signal, when asserted, is used to extend the refresh cycle by any number of periods of CLK until it is negated.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| ML                    |                                      | I                | MODE LOAD: This input signal, when low, enables the internal programming register that stores the programming information.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 2.2 VRAM COM          | NTROL SIGNALS                        |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| Q0-10<br>Q0-9<br>Q0-8 | DP8522A<br>DP8521A<br>DP8521A        | 0<br>0<br>0      | <b>VRAM ADDRESS:</b> These outputs are the multiplexed output of the R0–9, 10 and C0–9, 10 and form the VRAM address bus. These outputs contain the refresh address whenever a refresh is in progress. They contain high capacitive drivers with $20\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| RAS0-3                |                                      | 0                | <b>ROW ADDRESS STROBES:</b> These outputs are asserted to latch the row address contained on the outputs $Q0-8$ , 9, 10 into the VRAM. When a refresh is in progress, the RAS outputs are used to latch the refresh row address contained on the $Q0-8$ , 9, 10 outputs in the VRAM. These outputs contain high capacitive drivers with $20\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| CAS0-3                |                                      | 0                | <b>COLUMN ADDRESS STROBES:</b> These outputs are asserted to latch the column address contained on the outputs Q0–8, 9, 10 into the VRAM. These outputs have high capacitive drivers with $20\Omega$ series damping resistors.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| DT/OE                 |                                      | 0                | <b>DATA TRANSFER/OUTPUT ENABLE:</b> This output transitions low before $\overline{\text{RAS}}$ goes low and transitions high before $\overline{\text{RAS}}$ goes high during a video RAM shift register load operation (see $\overline{\text{VSRL}}$ pin description). During normal write accesses this output is held high, and for read accesses this output is asserted after $\overline{\text{CAS}}$ is asserted, and is negated after $\overline{\text{CAS}}$ negates.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

DP8520A/DP8521A/DP8522A

| Pin<br>Name     | Device (If not applicable to all) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|-----------------|-----------------------------------|------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.3 REFRESH     | SIGNALS                           |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| RFIP(RFRQ)      |                                   | 0                | <b>REFRESH IN PROGRESS</b> or <b>REFRESH REQUEST</b> : When $\overline{\text{ECASO}}$ is asserted during programming, this output functions as $\overline{\text{RFIP}}$ , and is asserted prior to a refresh cycle and is negated when all the $\overline{\text{RAS}}$ outputs are negated for that refresh. When $\overline{\text{ECASO}}$ is negated during programming, this output functions as $\overline{\text{RFRQ}}$ . When asserted, this pin specifies that 13 $\mu$ s or 15 $\mu$ s have passed. If $\overline{\text{DISRFSH}}$ is negated, the DP8520A/21A/22A will perform an internal refresh as soon as possible. If $\overline{\text{DISRFRSH}}$ is asserted, RFRQ can be used to externally request a refresh through the input RFSH. This output has a high capacitive driver and a 20 $\Omega$ series damping resistor. |
| RFSH            |                                   | I                | <b>REFRESH:</b> This input asserted with DISRFRSH already asserted will request a refresh. If this input is continually asserted, the DP8520A/21A/22A will perform refresh cycles in a burst refresh fashion until the input is negated. If RFSH is asserted with DISRFSH negated, the internal refresh address counter is cleared (useful for burst refreshes).                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| DISRFSH         |                                   | 1                | DISABLE REFRESH: This input is used to disable internal refreshes and must<br>be asserted when using RFSH for externally requested refreshes.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 2.4 PORT A AC   | CESS                              |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| ADS<br>(ALE)    |                                   |                  | ADDRESS STROBE or ADDRESS LATCH ENABLE: Depending on programming, this input can function as ADS or ALE. In mode 0, the input functions as ALE and when asserted along with CS causes an internal latch to be set. Once this latch is set an access will start from the positive clock edge of CLK as soon as possible. In Mode 1, the input functions as ADS and when asserted along with CS, causes the access RAS to assert if no other event is taking place. If an event is taking place, RAS will be asserted from the positive edge of CLK as soon as possible. In both cases, the low going edge of this signal latches the bank, row and column address if programmed to do so.                                                                                                                                                   |
| <u>CS</u>       |                                   | I                | CHIP SELECT: This input signal must be asserted to enable a Port A access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| AREQ            |                                   | I                | ACCESS REQUEST: This input signal in Mode 0 must be asserted some time after the first positive clock edge after ALE has been asserted. When this signal is negated, RAS is negated for the access. In Mode 1, this signal must be asserted before ADS can be negated. When this signal is negated, RAS is negated for the access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| WAIT<br>(DTACK) |                                   | 00               | WAIT or DTACK: This output can be programmed to insert wait states into a CPU access cycle. With R7 negated during programming, the output will function as a WAIT type output. In this case, the output will be active low to signal a wait condition. With R7 asserted during programming, the output will function as DTACK. In this case, the output will be negated to signify a wait condition and will be asserted to signify the access has taken place. Each of these signals can be delayed by a number of positive clock edges or negative clock levels of CLK to increase the microprocessor's access cycle through the insertion of wait states.                                                                                                                                                                              |
| WAITIN          |                                   | I                | WAIT INCREASE: This input can be used to dynamically increase the number of<br>positive clock edges of CLK until DTACK will be asserted or WAIT will be<br>negated during a VRAM access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 2.5 PORT B AC   | CESS SIGNALS                      |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| AREQB           | DP8522A<br>only                   | 1                | <b>PORT B ACCESS REQUEST:</b> This input asserted will latch the row, column and bank address if programmed, and requests an access to take place for Port B. If the access can take place, RAS will assert immediately. If the access has to be delayed, RAS will assert as soon as possible from a positive edge of CLK.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| ATACKB          | DP8522A<br>only                   | 0                | ADVANCED TRANSFER ACKNOWLEDGE PORT B: This output is asserted<br>when the access RAS is asserted for a Port B access. This signal can be used to<br>generate the appropriate DTACK or WAIT type signal for Port B's CPU or bus.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |

| Pin<br>Name     | Device (If not<br>applicable to all) | Input/<br>Output | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-----------------|--------------------------------------|------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2.6 COMMON      | DUAL PORT SIGNAL                     | .S               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| GRANTB          | DP8522A<br>only                      | 0                | <b>GRANT B:</b> This output indicates which port is currently granted access to the VRAM array. When GRANTB is asserted, Port B has access to the array. When GRANTB is negated, Port A has access to the VRAM array. This signal is used to multiplex the signals R0–8, 9, 10; C0–8, 9, 10; B0–1; WIN; LOCK and ECAS0–1 to the DP8522A when using dual accessing.                                                                                                                                                                                                                                                                           |
| LOCK            | DP8522A<br>only                      | I                | LOCK: This input can be used by the currently granted port to "lock out" the other port from the VRAM array by inserting wait states into the locked out port's access cycle until LOCK is negated.                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 2.7 VRAM TR     | ANSFER CYCLE SIGN                    | ALS              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| AVSRLRQ         |                                      | I                | ADVANCED VIDEO SHIFT REGISTER LOAD REQUEST: This must precede<br>the VSRL input going low by the amount of time necessary to guarantee that any<br>currently executing access and pending refresh can finish. This input disables<br>Port B and refresh requests until four CLK periods after VSRL has transitioned<br>low. This input may be held low until the video RAM transfer cycle is completed<br>or may be momentarily pulsed low.                                                                                                                                                                                                  |
| VSRL            |                                      | Ι                | <b>VIDEO SHIFT REGISTER LOAD:</b> This input causes the $\overline{\text{DT}}/\overline{\text{OE}}$ output to transition low immediately. Therefore, when executing a video RAM shift register load, VSRL transitions low before RAS goes low. The $\overline{\text{DT}}/\overline{\text{OE}}$ output will transition high from VSRL going high or four CLK periods (rising clock edges) from VSRL going low, whichever occurs first. VSRL low also disables the WIN input from affecting the $\overline{\text{DT}}/\overline{\text{OE}}$ logic, until the video shift register load access is over.                                         |
| 2.8 POWER SI    | GNALS AND CAPAC                      | ITOR INPU        | Т                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| V <sub>CC</sub> |                                      | 1                | POWER: Supply Voltage.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| GND             |                                      | I                | GROUND: Supply Voltage Reference.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| САР             |                                      | 1                | <b>CAPACITOR:</b> This input is used by the internal PLL for stabilization. The value of the ceramic capacitor should be 0.1 $\mu$ F and should be connected between this input and ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|                 | clock inputs to the DP               |                  | /22A, CLK and DELCLK. These two clocks may both be tied to the same clock input ifferent frequencies, asynchronous to each other.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| CLK             |                                      | I                | <b>SYSTEM CLOCK:</b> This input may be in the range of 0 Hz up to 25 MHz. This input is generally a constant frequency but it may be controlled externally to change frequencies or perhaps be stopped for some arbitrary period of time. This input provides the clock to the internal state machine that arbitrates between accesses and refreshes. This clock's positive edges and negative levels are used to extend the WAIT (DTACK) signals. The clock is also used as the reference for the RAS precharge time and RAS low time during refresh. All Port A and Port B accesses are assumed to be synchronous to the system clock CLK. |

|        |   | clock CLK.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|--------|---|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DELCLK | I | <b>DELAY LINE CLOCK:</b> The clock input DELCLK, may be in the range of 6 MHz to 20 MHz and should be a multiple of 2 (i.e., 6, 8, 10, 12, 14, 16, 18, 20 MHz) to have the DP8520A/21A/22A switching characteristics hold. If DELCLK is not one of the above frequencies the accuracy of the internal delay line will suffer. This is because the phase locked loop that generates the delay line assumes an input clock frequency of a multiple of 2 MHz. For example, if the DELCLK input is at 7 MHz and we choose a divide by 3 (program bits C0–2) this will produce 2.333 MHz which is 16.667% off of 2 MHz. Therefore, the DP8520A/21A/22A delay line would produce delays that are shorter (faster delays) than what is intended. If divide by 4 was chosen the delay line would be longer (slower delays) than intended (1.75 MHz instead of 2 MHz). (See Section 10 for more information.) This clock is also divided to create the internal refresh clock. |

# 3.0 Port A Access Modes

The DP8520A/21A/22A have two general purpose access modes. With one of these modes, any microprocessor can be interfaced to VRAM. A Port A access to VRAM is initiated by two input signals:  $\overline{\text{ADS}}$  (ALE) and  $\overline{\text{CS}}$ . The access is always terminated by one signal:  $\overline{\text{AREQ}}$ . These input signals should be synchronous to the input clock, CLK. One of these access modes is selected at programming through the B1 input signal. In both modes, once an access has been requested by  $\overline{\text{CS}}$  and  $\overline{\text{ADS}}$  (ALE), the DP8522A will guarantee the following:

The DP8520A/21A/22A will have the row address valid to the VRAMs' address bus, Q0–8, 9, 10 given that the row address setup time to the DP8520A/21A/22A was met;

The DP8520A/21A/22A will bring the appropriate  $\overline{\text{RAS}}$  or  $\overline{\text{RASs}}$  low;

The DP8520A/21A/22A will guarantee the minimum row address hold time, before switching the internal multiplexor to place the column address on the VRAM address bus, Q0-8, 9, 10;

The DP8520A/21A/22A will guarantee the minimum column address setup time before asserting the appropriate  $\overline{\text{CAS}}$  or  $\overline{\text{CASs}}$ ;

The DP8520A/21A/22A will hold the column address valid the minimum specified column address hold time in address pipelining mode and will hold the column address valid the remainder of the access in non-pipelining mode.

The chip includes a  $\overline{\text{WIN}}$  pin to signify a write operation to the DP8520A/21A/22A. When asserted,  $\overline{\text{WIN}}$  will cause  $\overline{\text{CAS}}$  to delay to the next positive clock edge if address bit C9 is asserted during programming. When negated,  $\overline{\text{WIN}}$  will cause the  $\overline{\text{DT}}/\overline{\text{OE}}$  output to follow the  $\overline{\text{CAS}}$  outputs for a read access, if  $\overline{\text{ECAS0}}$  is negated during programming. WE, write enable, must be externally gated from the processor to the VRAM as there is no output pin from the  $\overline{\text{WIN}}$  input pin available on chip.

#### 3.1 ACCESS MODE 0

Access Mode 0, shown in *Figure 5a*, is selected by negating the input B1 during programming. This access mode allows accesses to VRAM to always be initiated from the positive edge of the system input clock, CLK. To initiate a Mode 0 access, ALE is pulsed high and  $\overline{CS}$  is asserted. Pulsing ALE high and asserting  $\overline{CS}$ , sets an internal latch which requests an access. If the precharge time from the last access or VRAM refresh had been met and a refresh of VRAM, a Port B access, or a VRAM transfer cycle was not in progress, the RAS or group of RASs would be initiated from the first positive edge of CLK. If a VRAM refresh is in progress or precharge time is required, the controller will wait until these events have taken place and assert  $\overline{RAS}$  on the next positive edge of CLK.

Sometime after the first positive edge of CLK after ALE and  $\overline{CS}$  have been asserted, the input  $\overline{AREQ}$  must be asserted. In single port applications, once  $\overline{AREQ}$  has been asserted,  $\overline{CS}$  can be negated. Once  $\overline{AREQ}$  is negated,  $\overline{RAS}$  and  $\overline{DTACK}$ , if programmed, will be negated. If  $\overline{ECASO}$  is asserted during programming,  $\overline{CAS}$  will be negated with  $\overline{AREQ}$ . If  $\overline{ECASO}$  was negated during programming, a single  $\overline{CAS}$  or group of  $\overline{CASS}$  will continue to be asserted after  $\overline{RAS}$  has been negated given that the appropriate  $\overline{ECASO}$  is precharge time. ALE can stay asserted several periods of CLK. However, ALE must be negated before or during the period of CLK in which  $\overline{AREQ}$  is negated.

When performing address pipelining, the ALE input cannot be asserted to start another access until AREQ has been asserted for at least one clock period of CLK for the present access.

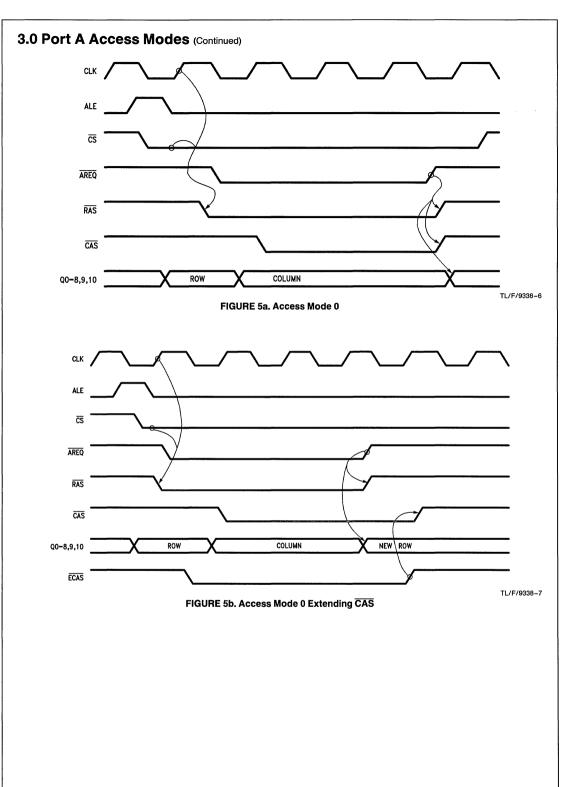
#### 3.2 ACCESS MODE 1

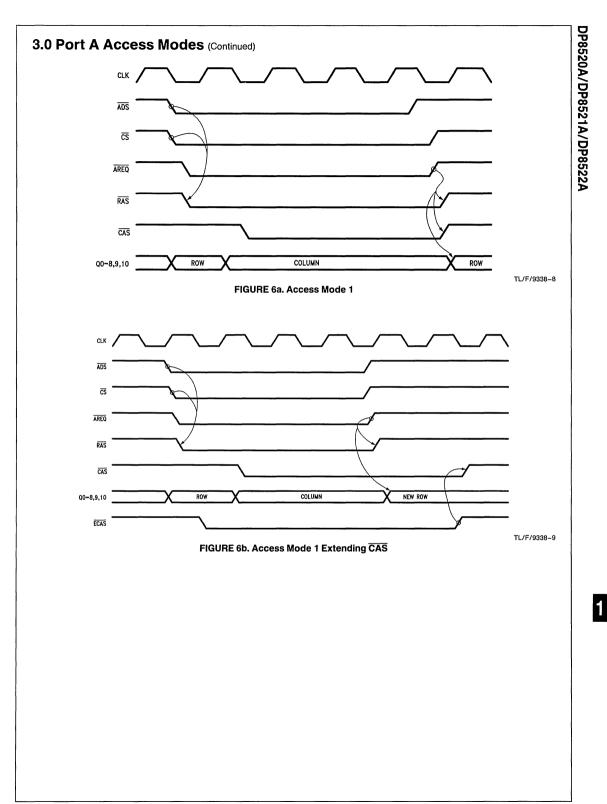
Access Mode 1, shown in Figure 6a, is selected by asserting the input B1 during programming. This mode allows accesses, which are not delayed by precharge. Port B access, VRAM transfer cycle or refresh, to start immediately from the access request input, ADS. To initiate a Mode 1 access, CS is asserted followed by ADS asserted. If the programmed precharge time from the last access or VRAM refresh had been met and a refresh of the VRAM, a Port B access to the VRAM, or a VRAM transfer cycle was not in progress, the RAS or group of RASs selected by programming and the bank select inputs would be asserted from ADS being asserted. If a VRAM refresh, a Port B access, or a VRAM transfer cycle is in progress or precharge time is required, the controller will wait until these events have taken place and assert  $\overline{RAS}$  or the group of  $\overline{RAS}$ s from the next positive edge of CLK.

When ADS is asserted or sometime after, AREQ must be asserted. At this time, ADS can be negated and AREQ will continue the access. Once AREQ is negated, RAS and DTACK, if programmed, will be negated. If ECAS0 was asserted during programming, CAS will be negated with AREQ. If ECAS0 was negated during programming, a single CAS or group of CASs will continue to be asserted after RAS has been negated given that the appropriate ECAS inputs were asserted as shown in *Figure 6b*. This allows a VRAM to have data present on the data out bus while gaining RAS precharge time. ADS can continue to be asserted after AREQ has been asserted and negated, however a new access would not be started until ADS is negated and asserted again. ADS and AREQ can be tied together in applications not using address pipelining.

If address pipelining is programmed, it is possible for  $\overline{\text{ADS}}$  to be negated after  $\overline{\text{AREQ}}$  is asserted. Once  $\overline{\text{AREQ}}$  is asserted,  $\overline{\text{ADS}}$  can be asserted again to initiate a new access.







# 4.0 Refresh Options

The DP8520A/21A/22A support a wide variety of refresh control mode options including automatic internally controlled refresh, externally controlled/burst refresh, refresh request/acknowledge and any combination of the above. With each of the control modes above, different types of refreshes can be performed. These different types include all  $\overline{\text{HAS}}$  refresh, staggered refresh and error scrubbing during all  $\overline{\text{RAS}}$  refresh.

There are three inputs, EXTNDRF,  $\overline{\text{RFSH}}$  and  $\overline{\text{DISRFSH}}$ , and one output,  $\overline{\text{RFIP}}$  ( $\overline{\text{RFRQ}}$ ), associated with refresh. There are also ten programming bits; RO-1, R9, CO-6 and  $\overline{\text{ECAS0}}$  used to program the various types of refreshing.

The two inputs,  $\overrightarrow{\text{RFSH}}$  and  $\overrightarrow{\text{DISRFSH}}$ , are used in the externally controlled/burst refresh mode and the refresh request/acknowledge mode. The output  $\overrightarrow{\text{RFRQ}}$  is used in the refresh request/acknowledge mode. The input EXTNDRF is used in all refresh modes and the output  $\overrightarrow{\text{RFIP}}$  is used in all refresh modes and the output  $\overrightarrow{\text{RFIP}}$  is used in all refresh modes except the refresh request/acknowledge mode. Asserting the input EXTNDRF, extends the refresh cycle single or multiple integral clock periods of CLK. The output  $\overrightarrow{\text{RFIP}}$  is asserted one period of CLK before the first refresh  $\overrightarrow{\text{RAS}}$  is asserted. If an access is currently in progress,  $\overrightarrow{\text{RFIP}}$  will be asserted up to one period of CLK before the first refresh  $\overrightarrow{\text{RAS}}$  is negated for the access (see *Figure 7a*).

The DP8520A/21A/22A will increment the refresh address counter automatically, independent of the refresh mode used. The refresh address counter will be incremented once all the refresh  $\overline{\text{RASs}}$  have been negated.

In every combination of refresh control mode and refresh type, the DP8520A/21A/22A is programmed to keep  $\overline{\text{RAS}}$  asserted a number of CLK periods. The values of  $\overline{\text{RAS}}$  low time during refresh are programmed with the programming bits R0 and R1.

# **4.1 REFRESH CONTROL MODES**

There are three different modes of refresh control. Any of these modes can be used in combination or singularly to produce the desired refresh results. The three different modes of control are: automatic internal refresh, external/ burst refresh and refresh request/acknowledge.

## 4.1.1 Automatic Internal Refresh

The DP8520A/21A/22A have an internal refresh clock. The period of the refresh clock is generated from the programming bits C0–3. Every period of the refresh clock, an internal refresh request is generated. As long as a VRAM access is not currently in progress and precharge time has been met, the internal refresh request will generate an automatic internal refresh. If a VRAM access is in progress, the DP8520A/21A/22A on-chip arbitration logic will wait until the access is finished before performing the refresh. The refresh/access arbitration logic can insert a refresh cycle between two address pipelined accesses. However, the refresh arbitration logic can not interrupt an access cycle to perform a refresh. To enable automatic internally controlled refreshes, the input DISRFSH must be negated.

#### 4.1.2 Externally Controlled/Burst Refresh

To use externally controlled/burst refresh, the user must disable the automatic internally controlled refreshes by asserting the input  $\overline{\text{DISRFSH}}$ . The user is responsible for generating the refresh request by asserting the input  $\overline{\text{RFSH}}$ .

Pulsing  $\overline{\text{RFSH}}$  low, sets an internal latch, that is used to produce the internal refresh request. The refresh cycle will take place on the next positive edge of CLK as shown in *Figure 7b*. If an access to VRAM is in progress or precharge time for the last access has not been met, the refresh will be delayed. Since pulsing  $\overline{\text{RFSH}}$  low sets a latch, the user does not have to keep  $\overline{\text{RFSH}}$  low until the refresh starts. When the last refresh RAS negates, the internal refresh request latch is cleared.

By keeping  $\overrightarrow{\text{RFSH}}$  asserted past the positive edge of CLK which ends the refresh cycle as shown in *Figure 8*, the user will perform another refresh cycle. Using this technique, the user can perform a burst refresh consisting of any number of refresh cycles. Each refresh cycle during a burst refresh will meet the refresh RAS low time and the RAS precharge time (programming bits R0–1).

If the user desires to burst refresh the entire VRAM (all row addresses) he could generate an end of count signal (burst refresh finished) by looking at one of the DP8520A/21A/22A high address outputs (Q7, Q8, Q9 or Q10) and the RFIP output. The Qn outputs function as a decode of how many row addresses have been refreshed (Q7 = 128 refreshes, Q8 = 256 refreshes, Q9 = 512 refreshes, Q10 = 1024 refreshes).

#### 4.1.3 Refresh Request/Acknowledge

The DP8520A/21A/22A can be programmed to output internal refresh requests. When the user programs ECAS0 negated during programming, the RFIP output functions as RFRQ. RFRQ will be asserted from a positive edge of CLK as shown in *Figure 9a*. Once RFRQ is asserted, it will stay asserted until the RFSH is pulsed low with DISRFSH asserted. This will cause an externally requested/burst refresh to take place. If DISRFSH is negated, an automatic internal refresh will take place as shown in *Figure 9b*.

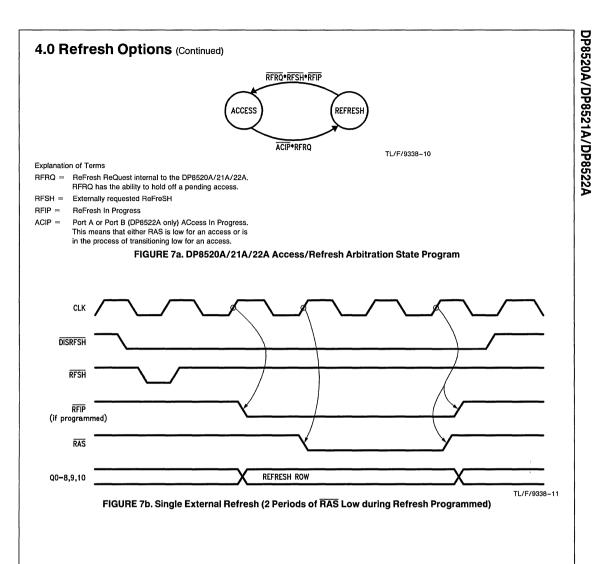
RFRQ will go high and then assert if additional periods of the internal refresh clock have expired and neither an externally controlled refresh nor an automatically controlled internal refresh have taken place as shown in *Figure 9c*. If a time critical event, or long access like page/static column mode access can not be interrupted, RFRQ pulsing high can be used to increment a counter. The counter can be used to perform a burst refresh of the number of refreshes missed (through the RFSH input).

## **4.2 REFRESH CYCLE TYPES**

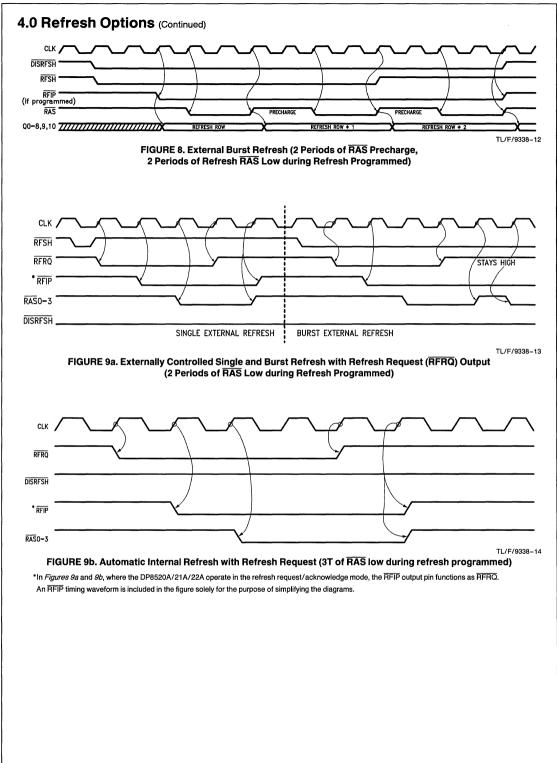
Three different types of refresh cycles are available for use. The three different types are mutually exclusive and can be used with any of the three modes of refresh control. The three different refresh cycle types are: all RAS refresh, staggered RAS refresh and error scrubbing during all RAS refresh. In all refresh cycle types, the RAS precharge time is guaranteed: between the previous access RAS ending and the refresh RAS0 starting; between burst refresh RAS3 ending and access RAS beginning; between burst refresh RAS3.

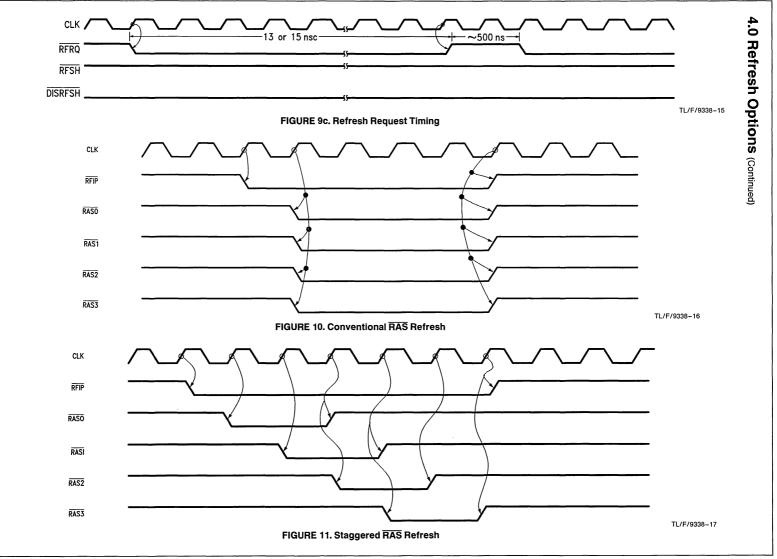
## 4.2.1 Conventional RAS Refresh

A conventional refresh cycle causes  $\overline{\text{RASO}}$ -3 to all assert from the first positive edge of CLK after  $\overline{\text{RFIP}}$  is asserted as shown in *Figure 10*.  $\overline{\text{RASO}}$ -3 will stay asserted until the number of positive edges of CLK programmed have passed. On the last positive edge,  $\overline{\text{RASO}}$ -3, and  $\overline{\text{RFIP}}$  will be negated. This type of refresh cycle is programmed by negating address bit R9 during programming.



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AS5289Q\Ars85289Q\Ars85228

### 4.0 Refresh Options (Continued)

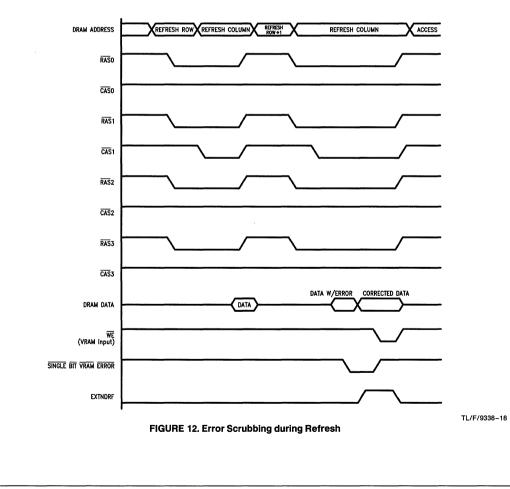
#### 4.2.2 Staggered RAS Refresh

A staggered refresh staggers each  $\overline{\text{RAS}}$  or group of  $\overline{\text{RASs}}$  by a positive edge of CLK as shown in *Figure 11*. The number of  $\overline{\text{RASs}}$ , which will be asserted on each positive edge of CLK, is determined by the  $\overline{\text{RAS}}$ ,  $\overline{\text{CAS}}$  configuration mode programming bits C4–C6. If single  $\overline{\text{RAS}}$  outputs are selected during programming, then each  $\overline{\text{RAS}}$  will assert on successive positive edges of CLK. If two  $\overline{\text{RAS}}$  outputs are selected during programming then  $\overline{\text{RAS}}$  outputs are selected during programming then  $\overline{\text{RAS}}$  outputs are selected for the first positive edge of CLK after  $\overline{\text{RFIP}}$  is asserted. RAS2 and  $\overline{\text{RAS}}$  will assert on the second positive edge of CLK after  $\overline{\text{RFIP}}$  is asserted. If all  $\overline{\text{RAS}}$  outputs were selected during programming, all  $\overline{\text{RAS}}$  outputs were selected during programming, all  $\overline{\text{RAS}}$  outputs were selected during programming, all  $\overline{\text{RAS}}$  outputs were selected assert on the first positive edge of CLK after  $\overline{\text{RFIP}}$  is asserted. Each  $\overline{\text{RAS}}$  or group of  $\overline{\text{RAS}}$  will meet the programmed  $\overline{\text{RAS}}$  low time and then negate.

#### 4.2.3 Error Scrubbing during Refresh

The DP8520A/21A/22A support error scrubbing during all RAS VRAM refreshes. Error scrubbing during refresh is selected through bits C4–C6 with bit R9 negated during programming. Error scrubbing can not be used with staggered refresh (see Section 9.0). Error scrubbing during refresh al-

lows a CAS or group of CASs to assert during the all RAS refresh as shown in Figure 12. This allows data to be read from the VRAM array and passed through an Error Detection And Correction Chip, EDAC. It is important to note that while an error scrubbing during refresh access is being peformed, it is the system designer's responsibility to properly control the WE input of the VRAM, WE should be high during the initial access of the VRAM, which could be accomplished by gating RFIP, if programmed, with the processor access circuitry that creates WE. If the EDAC determines that the data contains a single bit error and corrects that error, the refresh cycle can be extended with the input extend refresh, EXTNDRF, and a read-modify-write operation can be performed, and the corrected data can be written back to the VRAM by bringing WE low. The DP8522A has a 24-bit internal refresh address counter that contains the 11 row, 11 column and 2 bank addresses. The DP8520A/21A have a 22-bit internal refresh address counter that contains the 10 row, 10 column and 2 bank addresses. These counters are configured as bank, column, row with the row address as the least significant bits. The bank counter bits are then used with the programming selection to determine which  $\overline{CAS}$  or group of  $\overline{CAS}$ s will assert during a refresh.



## 4.0 Refresh Options (Continued)

#### 4.3 EXTENDING REFRESH

The programmed number of periods of CLK that refresh RASs are asserted can be extended by one or multiple periods of CLK. Only the all RAS (with or without error scrubbing) type of refresh can be extended. To extend a refresh cycle, the input extend refresh, EXTNDRF, must be asserted before the positive edge of CLK that would have negated all the RAS outputs during the refresh cycle and after the positive edge of CLK which starts all RAS outputs during the refresh as shown in *Figure 13*. This will extend the refresh to the next positive edge of CLK and EXTNDRF will be sampled again. The refresh cycle will continue until EXTNDRF is sampled low on a positive edge of CLK.

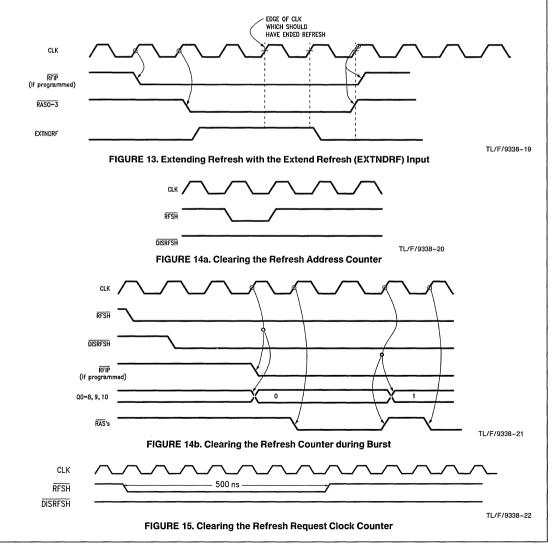
#### 4.4 CLEARING THE REFRESH ADDRESS COUNTER

The refresh address counter can be cleared by asserting RFSH while DISRFSH is negated as shown in *Figure 14a*. This can be used prior to a burst refresh of the entire memo-

ry array. By asserting **FFSH** one period of CLK before DISRFSH is asserted and then keeping both inputs asserted, the DP8520A/21A/22A will clear the refresh address counter and then perform refresh cycles separated by the programmed value of precharge as shown in *Figure 14b*. An end-of-count signal can be generated from the Q VRAM address outputs of the DP8520A/21A/22A and used to negate **RFSH**.

#### 4.5 CLEARING THE REFRESH REQUEST CLOCK

The refresh request clock can be cleared by negating DISRFSH and asserting RFSH for 500 ns, one period of the internal 2 MHz clock as shown in *Figure 15*. By clearing the refresh request clock, the user is guaranteed that an internal refresh request will not be generated for approximately 15  $\mu$ s, one refresh clock period, from the time RFSH is negated. This action will also clear the refresh address counter.



## 5.0 Port A Wait State Support

Wait states allow a CPU's access cycle to be increased by one or multiple CPU clock periods. The wait or ready input is named differently by CPU manufacturers. However, any CPU's wait or ready input is compatible with either the WAIT or DTACK output of the DP8520A/21A/22A. The user determines whether to program WAIT or DTACK (R7) and which value to select for WAIT or DTACK (R2, R3) depending upon the CPU used and where the CPU samples its wait input during an access cycle.

The decision to terminate the CPU access cycle is directly affected by the speed of the VRAMs used. The system designer must ensure that the data from the VRAMs will be present for the CPU to sample or that the data has been written to the VRAM before allowing the CPU access cycle to terminate.

The insertion of wait states also allows a CPU's access cycle to be extended until the VRAM access has taken place. The DP8520A/21A/22A insert wait states into CPU access cycles due to; guaranteeing precharge time, refresh currently in progress, user programmed wait states, the WAITIN signal being asserted and GRANTB not being valid (DP8522A only). If one of these events is taking place and the CPU starts an access, the DP8520A/21A/22A will insert wait states into the access cycle, thereby increasing the length of the CPU's access. Once the event has been completed, the DP8520A/21A/22A will allow the access to take place and stop inserting wait states.

There are six programming bits, R2–R7; an input, WAITIN; and an output that functions as WAIT or DTACK.

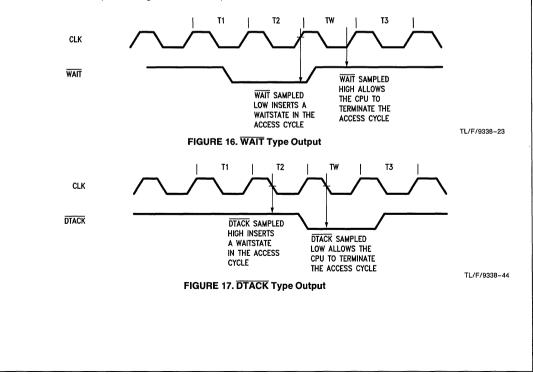
#### **5.1 WAIT TYPE OUTPUT**

With the R7 address bit negated during programming, the user selects the  $\overline{WAIT}$  output. As long as  $\overline{WAIT}$  is sampled

asserted by the CPU, wait states (extra clock periods) are inserted into the current access cycle as shown in *Figure 16.* Once WAIT is sampled negated, the access cycle is completed by the CPU. WAIT is asserted at the beginning of a chip selected access and is programmed to negate a number of positive edges and/or negative levels of CLK from the event that starts the access. WAIT can also be programmed to function in page/burst mode applications. Once WAIT is negated during an access, and the ECAS inputs are negated with  $\overline{AREQ}$  asserted, WAIT can be programmed to toggle, following the ECAS inputs. Once  $\overline{AREQ}$ is negated, ending the access. WAIT will stay negated until the next chip selected access. For more details about WAIT Type Output, see Application Note AN-773.

#### 5.2 DTACK TYPE OUTPUT

With the R7 address bit asserted during programming, the user selects the DTACK type output. As long as DTACK is sampled negated by the CPU, wait states are inserted into the current access cycle as shown in Figure 17. Once DTACK is sampled asserted, the access cycle is completed by the CPU. DTACK, which is normally negated, is programmed to assert a number of positive edges and/or negative levels from the event that starts RAS for the access. DTACK can also be programmed to function during page/ burst mode accesses. Once DTACK is asserted and the ECAS inputs are negated with AREQ asserted, DTACK can be programmed to negate and assert from the ECAS inputs toggling to perform a page/burst mode operation. Once AREQ is negated, ending the access, DTACK will be negated and stays negated until the next chip selected access. For more details about DTACK Type Output, see Application Note AN-773.



# 5.0 Port A Wait State Support (Continued)

# 5.3 WAIT STATE SUPPORT FOR VIDEO RAM SHIFT REGISTER LOAD OPERATIONS FOR PORT A

If using the DP8520A/21A/22A in a system using video VRAMs, the CPU that controls loading the Video RAM shift register must be connected to Port A. The input  $\overline{AVSRLRQ}$  asserts, signaling an advanced request for a Video RAM shift register load operation. Sometime later, the input  $\overline{VSRL}$  asserts, signifying that the transfer cycle has started, and this action causes the  $\overline{DT}/\overline{OE}$  output to transfer low.  $\overline{VSRL}$  asserts galso asserts  $\overline{WAIT}$  (keeps  $\overline{DTACK}$  negated) and

will then insert wait states into the transfer cycle. The transfer cycle is completed from either VSRL negating or four clocks from VSRL asserting. The first event of these two to take place causes WAIT to negate (DTACK to assert) immediately or one half system clock period later, depending on how the user had programmed WAIT to end (DTACK to start) during a non-burst type of access. The wait logic is intimately connected to the DP8520A/21A/22A graphics functions and the WAIT output functions the same as the DT/OE output (see *Figure 18*).

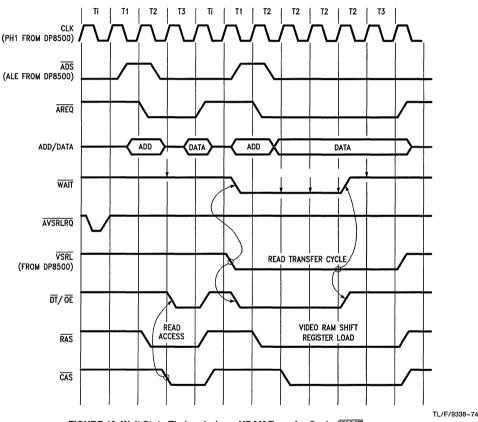


FIGURE 18. Wait State Timing during a VRAM Transfer Cycle (WAIT Programmed as OT, WAIT Sampled at the "T3" Rising Clock Edge)

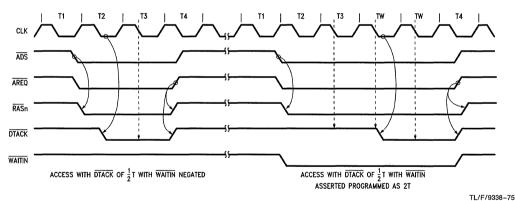
### 5.0 Port A Wait State Support (Continued) 5.4 DYNAMICALLY INCREASING THE NUMBER OF WAIT STATES

The user can increase the number of positive edges of CLK before DTACK is asserted or WAIT is negated. With the input WAITIN asserted, the user can delay DTACK asserting or WAIT negating either one or two more positive edges of CLK. The number of edges is programmed through address bit R6. If the user is increasing the number of positive edges in a delay that contains a negative level, the positive edges will be met before the negative level. For example if the user programmed DTACK of 1/2T, asserting WAITIN, programmed as 2T, would increase the number of positive edges resulting in DTACK of 21/3T as shown in Figure 19. Similarly, WAITIN can increase the number of positive edges in a page/burst access. WAITIN can be permanently asserted in systems requiring an increased number of wait states. WAITIN can also be asserted and negated, depending on the type of access. As an example, a user could invert the WRITE line from the CPU and connect the output to WAITIN. This could be used to perform write accesses with 1 wait state and read accesses with 2 wait states as shown in Figure 20.

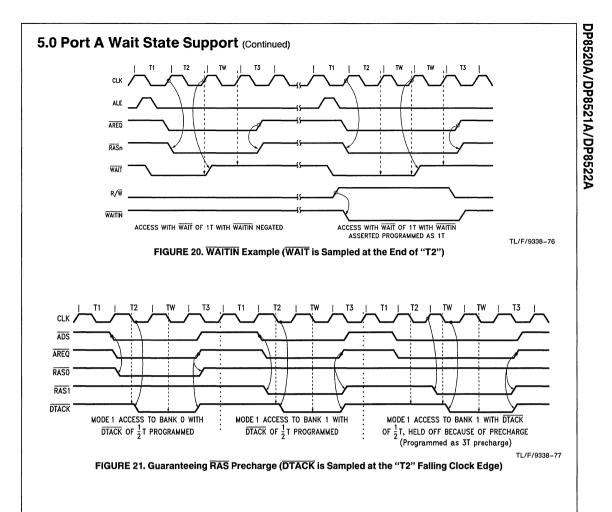
#### 5.5 GUARANTEEING RAS LOW TIME AND RAS PRECHARGE TIME

The DP8520A/21A/22A will guarantee  $\overline{\text{RAS}}$  precharge time between accesses; between refreshes; and between access and refreshes. The programming bits R0 and R1 are used to program combinations of  $\overline{\text{RAS}}$  precharge time and  $\overline{\text{RAS}}$  low time referenced by positive edges of CLK.  $\overline{\text{RAS}}$ low time is programmed for refreshes only. During an access, the system designer guarantees the time  $\overline{\text{RAS}}$  is asserted through the DP8520A/21A/22A wait logic. Since inserting wait states into an access increases the length of the CPU signals which are used to create  $\overline{\text{ADS}}$  or ALE and  $\overline{\text{AREQ}}$ , the time that  $\overline{\text{RAS}}$  is asserted can be guaranteed.

Precharge time is also guaranteed by the DP8520A/21A/ 22A. Each  $\overrightarrow{RAS}$  output has a separate positive edge of CLK counter.  $\overrightarrow{AREQ}$  is negated setup to a positive edge of CLK to terminate the access. That positive edge is 1T. The next positive edge is 2T.  $\overrightarrow{RAS}$  will not be asserted until the programmed number of positive edges of CLK have passed as shown in *Figure 21*. Once the programmed precharge time has been met,  $\overrightarrow{RAS}$  will be asserted from the positive edge of CLK. However, since there is a precharge counter per  $\overrightarrow{RAS}$ , an access using another  $\overrightarrow{RAS}$  will not be delayed. Precharge time before a refresh is always referenced from the access  $\overrightarrow{RAS}$  negating before  $\overrightarrow{RAS}$  for the refresh asserting. After a refresh, precharge time is referenced from  $\overrightarrow{RAS}$  negating, for the refresh, to the access  $\overrightarrow{RAS}$  asserting.







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# 6.0 DP8520A/21A/22A Video RAM Support

The DP8520A/21A/22A provides full support for all access modes of video RAMs through the addition of three pins (AVSRLRQ, VSRL, and DT/ $\overline{OE}$ ) to the standard DP8420A/21A/22A. The access modes of video RAMs can be split up into two groups; video RAM transfer cycles (read with the serial port in active or in standby mode, write, and pseudo write transfer cycles), and non-transfer cycles. The DP8520A/21A/22A support of video RAMs allows the full capabilities of the National Semiconductor Advanced Graphics chip set (DP8500 Series) to be realized. See *Figures 22, 23*, and *58a*.

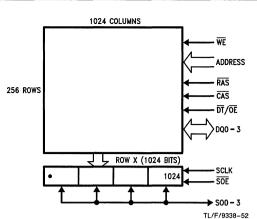
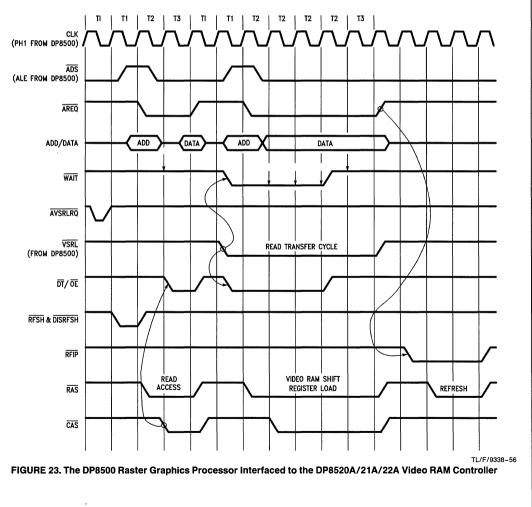


FIGURE 22. The Video RAM (A Dual Ported Memory) Ideal solution for graphics frame buffer. Screen refresh can occur at the same time as random access to the frame buffer for screen update and manipulation.



### 6.0 DP8520A/21A/22A Video RAM Support (Continued)

#### 6.1 SUPPORT FOR VRAM TRANSFER CYCLES (TO THE SERIAL PORT OF THE VRAM)

The DP8520A/21A/22A supports VRAM transfer cycles with the serial port in the active or standby mode. Active or standby refers to whether data is or is not currently being shifted in or out of the VRAM serial port (i.e., whether the shift clock (SCLK) is currently active). The DP8520A/21A/22A support for data transfer cycles with the serial port in the active mode includes the ability to support transfer cycles with the serial port in the standby mode. Hereafter, the term VRAM transfer cycle means VRAM transfer cycle with the serial port in the active mode.

In order to support VRAM transfer cycles, the DP8520A/ 21A/22A must be able to guarantee timing with respect to its input CLK (which must be synchronous to VRAM shift clock), RAS, CAS, and DT/OE. Figure 23 shows the timing graphics system memory where the of а DP8520A/21A/22A is being used with the National Semiconductor DP8500 Raster Graphics Processor (RGP). If the DP8520A/21A/22A is being used in a graphics frame buffer application, it has the ability to support a VRAM transfer cycle during active video time (ex. mid scan line). This is one of the very attractive features supported by the National Semiconductor Advanced Graphics chip set. Most of the commercial graphics controller chip sets available will only support VRAM transfer cycles during blanking periods (while the VRAM is in standby mode).

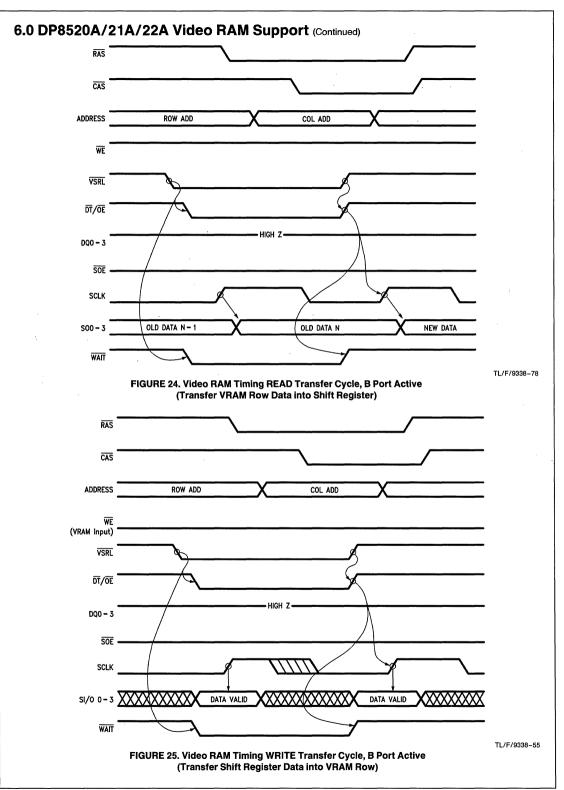
The DP8520A/21A/22A supports VRAM transfer cycles during active video time by being able to guarantee an exact instant during which the transfer of VRAM data to the VRAM shift register will occur. This exact instant can be guaranteed through the AVSRLRQ and VSRL inputs.

The input AVSRLRQ disables any further internally or externally requested refreshes or Port B access requests from being executed. The AVSRLRQ input does this by making the VRAM controller arbitration logic think that a Port A access is in progress from the point where the AVSRLRQ input asserts until the VRAM shift register load operation is completed. *Figure 23* shows the case of an externally requested refresh being disabled, because of a previous AVSRLRQ, until the VRAM shift register load has been completed.

The VSRL input causes the  $\overline{\text{DT}}/\overline{\text{OE}}$  output to assert immediately, regardless of what else may be happening in the DP8520A/21A/22A. Therefore, it is the system designer's responsibility to guarantee that all pending accesses have been completed by the time the  $\overline{\text{VSRL}}$  input asserts. The system designer can guarantee this by issuing  $\overline{\text{AVSRLRQ}}$  far enough in advance to guarantee that all pending accesses es have been completed by the time  $\overline{\text{VSRL}}$  asserts.

The  $\overline{\text{AVSRLRQ}}$  input does not override the  $\overline{\text{LOCK}}$  input (see Section 12.0) for dual port systems, and as a result, the designer must also guarantee that Port A can be accessed by assuring that GRANTB and  $\overline{\text{LOCK}}$  are both not asserted when  $\overline{\text{AVSRLRQ}}$  is asserted.

Generally, the VSRL is the status of the upcoming access cycle (of the graphics processor). Therefore, this input precedes the inputs ADS and AREQ that execute the VRAM shift register load transfer cycle. This sequence of events guarantees the correct relationship of DT/OE, RAS and CAS (DT preceding RAS and CAS when asserting and negating). The wait logic is also intimately connected to the graphics functions on the DP8520A/21A/22A. The DT/OE (and WAIT/DTACK) relationship to VSRL during a VRAM transfer cycle depends upon how the DP8520A/21A/22A was programmed with respect to the ECASO input. If ECASO was negated during programming, the DT/OE output will follow the VSRL input. If ECASO was asserted during programming, the DT/OE output will follow VSRL asserting. DT/OE will then negate either when VSRL negates or from the fourth rising clock edge after VSRL asserted, whichever event takes place first. This allows DT to negate before RAS and CAS negate, thus guaranteeing the correct timing relationship during the transfer cycle (see Figure 23). The WE input of the VRAM determines whether the access is a read or write transfer cycle (see Figures 24 and 25 respectively).



# 6.0 DP8520A/21A/22A Video RAM Support (Continued)

During a transfer cycle (VSRL asserted during the access) WIN is disabled from affecting the  $\overline{\text{DT}}/\overline{\text{OE}}$  logic until the transfer cycle is completed as shown by  $\overline{\text{CAS}}$  negating. During a transfer cycle, the  $\overline{\text{SOE}}$  (Serial Output Enable) input to the VRAM is asserted and is used as an output control for a read transfer cycle and is used as a write enable control during a write transfer cycle. When  $\overline{\text{SOE}}$  is negated, serial access is disabled, and a transfer cycle cannot take place.  $\overline{\text{SOE}}$  asserted during a read enables the serial input/output bus SI/O (0–3) while the VRAM data bus (DQ0–3) is put into a high impedance state, thus allowing the transfer cycle to take place from the serial port. In addition to both read and write transfer cycles, the DP8520A/21A/22A also supports pseudo write transfer cycles (see *Figure 26*). A pseudo write transfer cycle must be performed after a read transfer cycle if the subsequent operation is a write transfer cycle. The DP8520A/21A/22A VRAM controller is operated as if it is doing a write transfer cycle, but since the <u>SOE</u> input to the VRAM is negated (disabling the serial port), a transfer doesn't take place. The purpose of this pseudo write transfer cycle is to switch the SI/O (0–3) lines of the VRAM's serial port from output mode to input mode.

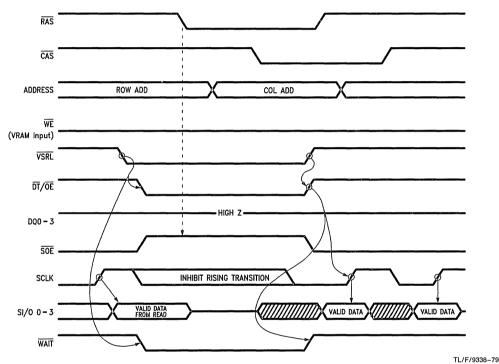


FIGURE 26. Video RAM Timing Pseudo WRITE Transfer Cycle, B Port Active (Transfer Shift Register Data into VRAM Row)

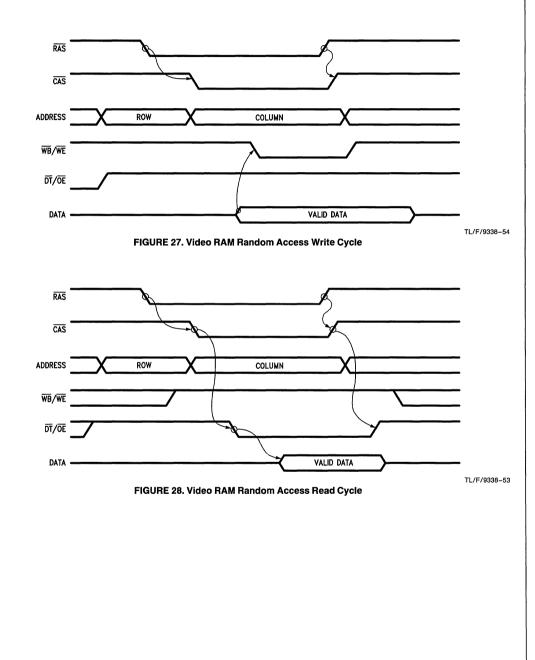
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## 6.0 DP8520A/21A/22A Video RAM Support (Continued)

# 6.2 SUPPORT FOR VRAM ACCESS CYCLES THROUGH PORT A USING THE DP8520A/21A/22A

With the DP8520A/21A/22A, the output  $\overline{\text{DT}}/\overline{\text{OE}}$  will remain negated during write accesses (see *Figure 27*), but during read accesses it will assert after CASn asserts.  $\overline{\text{DT}}/\overline{\text{OE}}$  will

be negated for a read access once  $\overline{CASn}$  is negated (see *Figure 28*), causing the VRAM outputs to be enabled. If  $\overline{CASn}$  toggles during a page mode read access, then the  $\overline{DT}/\overline{OE}$  logic will also toggle following the  $\overline{CASn}$  input.



# 7.0 Additional Access Support Features

To support the different modes of accessing, the DP8520A/ 21A/22A have multiple access features. These features allow the user to take advantage of CPU or VRAM functions. These additional features include: address latches and column increment for page/burst mode support; address pipelining to allow a new access to start to a different bank of VRAM after  $\overline{CAS}$  has been asserted and the column address hold time has been met; and delay  $\overline{CAS}$ , to allow the user with a multiplexed bus to ensure valid data is present before  $\overline{CAS}$  is asserted.

#### 7.1 ADDRESS LATCHES AND COLUMN INCREMENT

The address latches can be programmed, through programming bit B0, to either latch the address or remain permanently in fall-through mode. If the address latches are used to latch the address, the rising edge of ALE in Mode 0 places the latches in fall-through. Once ALE is negated, the address present on the row, column and bank inputs is latched. In Mode 1, the address latches are in fall-through mode until  $\overline{\text{ADS}}$  is asserted.  $\overline{\text{ADS}}$  asserted latches the address.

Once the address is latched, the column address can be incremented with the input COLINC. With COLINC asserted, the column address is incremented. If COLINC is asserted with all of the bits of the column address asserted, the column address will return to zero. COLINC can be used for sequential accesses of static column VRAMs. COLINC can also be used with the ECAS inputs to support sequential accesses to page mode VRAMs as shown in *Figure 29*. COLINC should only be asserted when a refresh is not in progress as indicated by  $\overrightarrow{\text{RFIP}}$ , if programmed, being negated during an access ince this input functions as an extend refresh when a refresh is in progress.

The address latches function differently with the DP8522A. The DP8522A will latch the address of the currently granted port. If Port A is currently granted, the address will be latched as described in Section 7.1. If Port A is not granted, and requests an access, the address will be latched on the first or second positive edge of CLK after GRANTB has been negated depending on the programming bits R0, R1. For Port B, if GRANTB is asserted, the address will be latched with  $\overline{AREQB}$  asserted. If GRANTB is negated, the address will latch on the first or second positive edge of CLK after GRANTB is asserted depending on the programming bits R0. R1.

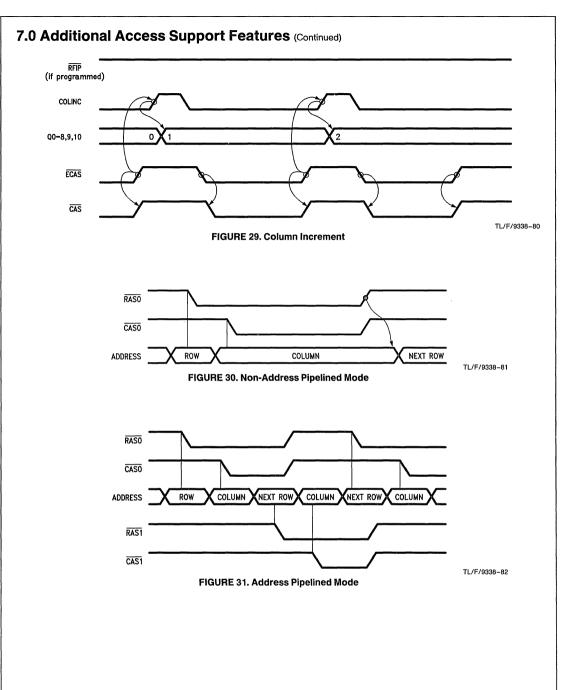
#### 7.2 ADDRESS PIPELINING

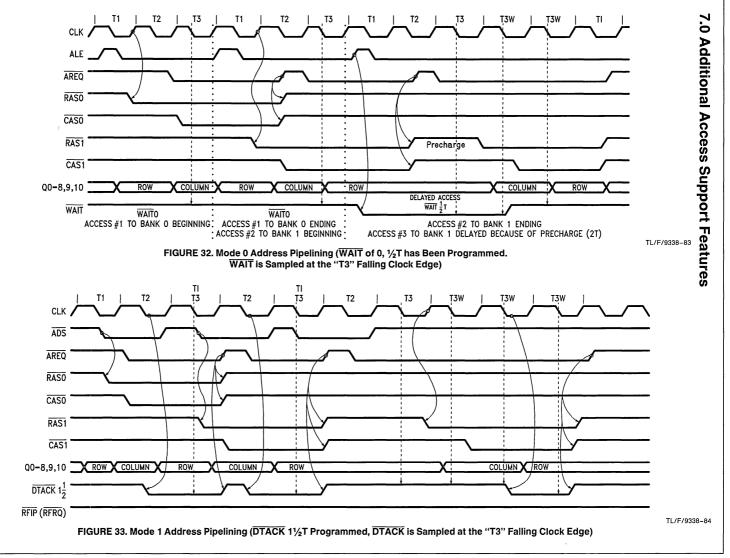
Address pipelining is the overlapping of accesses to different banks of VRAM. If the majority of successive accesses are to a different bank, the accesses can be overlapped. Because of this overlapping, the cycle time of the VRAM accesses are greatly reduced. The DP8520A/21A/22A can be programmed to allow a new row address to be placed on the VRAM address bus after the column address hold time has been met. At this time, a new access can be initiated with ADS or ALE, depending on the access mode, while AREQ is used to sustain the current access. The DP8522A supports address pipelining for Port A only. This mode can not be used with page, static column or nibble modes of operations because the VRAM column address is switched back to the row address after CAS is asserted. This mode is programmed through address bit R8 (see Figures 30 and 31).

During address pipelining in Mode 0, shown in *Figure 32*, ALE cannot be pulsed high to start another access until  $\overline{AREQ}$  has been asserted for the previous access for at least one period of CLK. DTACK, if programmed, will be negated once  $\overline{AREQ}$  is negated. WAIT, if programmed to insert wait states, will be asserted once ALE and  $\overline{CS}$  are asserted.

In Mode 1, shown in *Figure 33*, ADS can be negated once AREQ is asserted. After meeting the minimum negated pulse width for ADS, ADS can again be asserted to start a new access. DTACK, if programmed, will be negated once AREQ is negated. WAIT, if programmed, will be asserted once ADS is asserted.

In either mode with either type of wait programmed, the DP8520A/21A/22A will still delay the access for precharge if sequential accesses are to the same bank or if a refresh takes place.



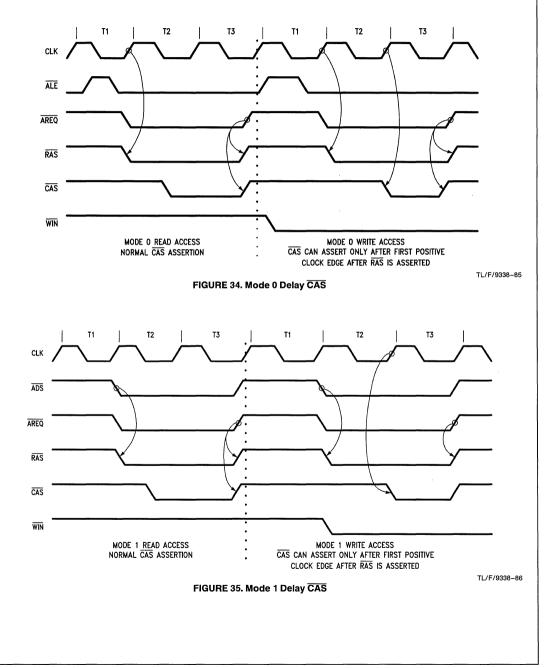


# 7.0 Additional Access Support Features

#### 7.3 DELAY CAS DURING WRITE ACCESSES

Address bit C9 asserted during programming will cause  $\overline{CAS}$  to be delayed until the first positive edge of CLK after  $\overline{RAS}$  is asserted when the input  $\overline{WIN}$  is asserted. Delaying  $\overline{CAS}$  during write accesses ensures that the data to be written to

VRAM will be setup to  $\overline{CAS}$  asserting as shown in *Figures* 34 and 35. If the possibility exists that data still may not be present after the first positive edge of CLK,  $\overline{CAS}$  can be delayed further with the  $\overline{ECAS}$  inputs. If address bit C9 is negated during programming, read and write accesses will be treated the same (with regard to  $\overline{CAS}$ ).



# 8.0 $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ Configuration Modes

The DP8520A/21A/22A allow the user to configure the VRAM array to contain one, two or four banks of VRAM. Depending on the functions used, certain considerations must be used when determining how to set up the VRAM array. Programming address bits C4, C5 and C6 along with bank selects, B0–1, and CAS enables, ECAS0–1, determine which RAS or group of RASs and which CAS or group of CASs will be asserted during an access. Different memory schemes are described. The DP8520A/21A/22A is specified driving a heavy load of 72 VRAMs, representing four banks of VRAM with 16-bit words and 2 parity bits. The DP8520A/21A/22A can drive more than 72 VRAMs, but the AC timing must be increased. Since the RAS and CAS outputs are configurable, all RAS and CAS outputs should be used for the maximum amount of drive.

#### 8.1 BYTE WRITING

By selecting a configuration in which all  $\overline{CAS}$  outputs are selected during an access, each  $\overline{ECAS}$  input enables a pair of  $\overline{CAS}$  outputs to select a byte in a word size of up to 16 bits. In this case, the  $\overline{RAS}$  outputs are used to select which of up to 4 banks is to be used as shown in *Figures 36* and *37*. The user can also configure the VRAM array into an 8 bank system as shown in *Figure 38*. This setup can be used along with byte writing for an 8-bit system if the  $\overline{LOW}$  BYTE and HIGH BYTE are connected to  $\overline{ECAS0}$  and  $\overline{ECAS1}$  respectively. The user can connect upper address bits to  $\overline{ECAS0}$ , 1 for use in an 8 bank-16-bit system, but cannot use byte writing in this case.

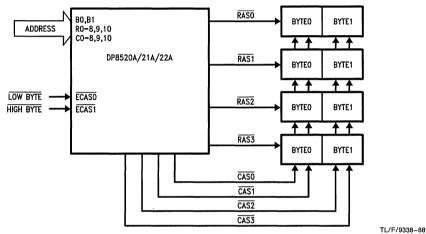
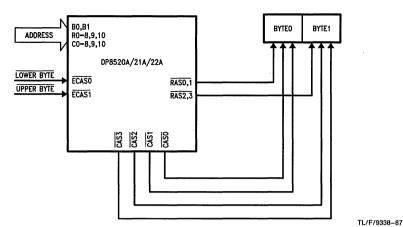
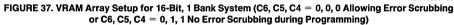


FIGURE 36. VRAM Array Setup for 16-Bit System (C6, C5, C4 = 1, 1, 0 during Programming)

# 8.0 RAS and CAS Configuration Modes (Continued)





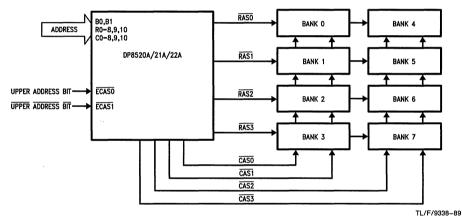


FIGURE 38. 8 Bank VRAM Array (C6, C5, C4 = 1, 1, 0 during Programming)

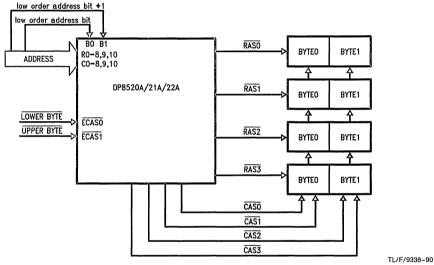
# 8.0 RAS and CAS Configuration Modes (Continued)

#### 8.2 MEMORY INTERLEAVING

Memory interleaving allows the cycle time of VRAMs to be reduced by having sequential accesses to different memory banks. Since the DP8520A/21A/22A have separate precharge counters per bank, sequential accesses will not be delayed if the accessed banks use different RAS outputs. To ensure different RAS outputs will be used, a mode is selected where either one or two RAS outputs will be asserted during an access. The bank select or selects, B0 and B1, are then tied to the least significant address bits, causing a different group of RASs to assert during each sequential access as shown in *Figure 39*. In this figure there should be at least one clock period of all RAS's negated between different RAS's being asserted to avoid the condition of a CAS before RAS refresh cycle.

#### 8.3 ADDRESS PIPELINING

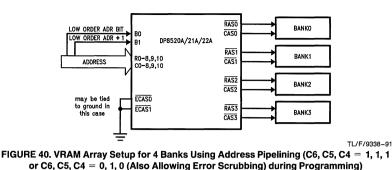
Address pipelining allows several access  $\overline{\text{RASs}}$  to be asserted at once. Because  $\overline{\text{RASs}}$  can overlap, each bank requires either a mode where one  $\overline{\text{RAS}}$  and one  $\overline{\text{CAS}}$  are used per bank as shown in *Figure 40* or where two  $\overline{\text{RASs}}$  and two  $\overline{\text{CASs}}$  are used per bank as shown in *Figure 41*. In order to perform byte writing while using address pipelining, external gating on the  $\overline{\text{CAS}}$  outputs must be used. If the array is not layed out this way, a  $\overline{\text{CAS}}$  to a bank can be low before  $\overline{\text{RASs}}$ , which will cause a refresh of the VRAM, not an access. To take full advantage of address pipelining, memory interleaving is used. To memory interleave, the least significant address bits should be tied to the bank select inputs to ensure that all "back to back" sequential accessed.

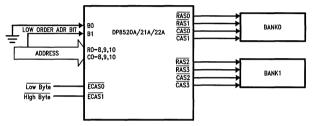




1

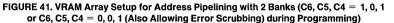
# 8.0 RAS and CAS Configuration Modes (Continued)





TL/F/9338-92

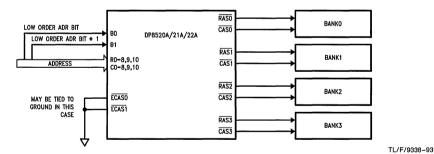
TL/F/9338-94



#### **8.4 ERROR SCRUBBING**

In error scrubbing during refresh, the user selects one, two or four  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  outputs per bank. When performing error detection and correction, memory is always accessed

as words. Since the  $\overline{CAS}$  signals are not used to select individual bytes, their corresponding  $\overline{ECAS}$  inputs can be tied low as shown in *Figures 42* and *43*.





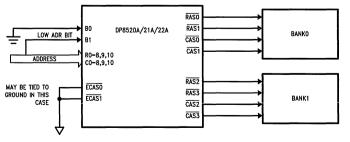


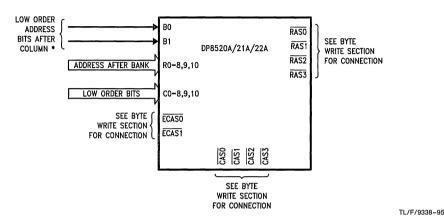
FIGURE 43. VRAM Array Setup for Error Scrubbing with 2 Banks (C6, C5, C4 = 0, 0, 1 during Programming)

# 8.0 RAS and CAS Configuration Modes (Continued)

### 8.5 PAGE/BURST MODE

In a static column, page or burst mode system, the least significant bits must be tied to the column address in order to ensure that the page/burst accesses are to sequential memory addresses, as shown in *Figure 44*. In a nibble mode system, the two least significant address bits (A2, A3) must be tied to the highest row and column address inputs (depends on VRAM size) to ensure that the toggling bits of nibble mode VRAMs are to sequential memory addresses.

The ECAS inputs may then be toggled with the DP8520A/ 21A/22A's address latches in fall-through mode, while  $\overline{AREQ}$  is asserted. The ECAS inputs can also be used to select individual bytes. When using nibble mode VRAMS, the third and fourth address bits can be tied to the bank select inputs to perform memory interleaving. In page or static column modes, the two address bits after the page size can be tied to the bank select inputs to select a new bank if the page size is exceeded.



\*See table below for row, column & bank address bit map. A0.A1 are used for byte addressing in this example.

| Addresses         | Nibble Mode*                | Page Mode/Static Column Mode Page Size |                           |                         |                |  |  |  |  |
|-------------------|-----------------------------|----------------------------------------|---------------------------|-------------------------|----------------|--|--|--|--|
| Addresses         | NUDDIE MOUE                 | 256 Bits/Page                          | 512 Bits/Page             | 1024 Bits/Page          | 2048 Bits/Page |  |  |  |  |
| Column<br>Address | R9, C9 = A2, A3<br>C0-8 = X | C0-7 = A2-9<br>C8-10 = X               | C0-8 = A2-10<br>C9,10 = X | C0-9 = A2-11<br>C10 = X | C0-10 = A2-12  |  |  |  |  |
| Row<br>Address    | х                           | x                                      | x                         | x                       | х              |  |  |  |  |
| B0<br>B1          | A4<br>A5                    | A10<br>A11                             | A11<br>A12                | A12<br>A13              | A13<br>A14     |  |  |  |  |

\*Assuming 1 M-bit Vrams are being used.

Assume that the least significant address bits are used for byte addressing. Given a 32-bit system A0,A1 would be

used for byte addressing.

X = DON'T CARE, the user can do as he pleases.

FIGURE 44. Page, Static Column, Nibble Mode System

# 9.0 Programming and Resetting

The DP8520A/21A/22A must be programmed by one of two possible programming sequences before it can be used. After power up, the DP8520A/21A/22A must be externally reset (see External Reset) before programming. After programming, the DP8520A/21A/22A enters a 60 ms initialization period. During this initialization period, the DP8520A/ 21A/22A performs refreshes about every 15 µs; this makes further VRAM warmup cycles unnecessary. The chip can be programmed as many times as the user wishes. After the first programming, the 60 ms initialization period will not be entered into unless the chip is reset. Refreshes occur during the 60 ms initialization period. If ECAS0 was asserted during programming, the RFIP (RFRQ) pin will act as RFIP and will be asserted throughout the initialization period, otherwise the pin will act like  $\overline{\text{RFRQ}}$  and toggle every 13  $\mu$ s-15  $\mu$ s in conjunction with internal refresh requests. If the user attempts an access during the initialization period, wait states will be inserted into the access cycle until the initialization period is complete and RAS precharge time has been met. The actual initialization time period is given by the following formula:



\*(Refresh Clock Fine Tune) /(DELCK Frequency)

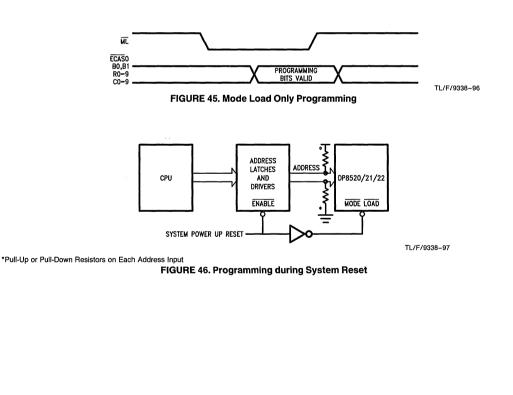
#### 9.1 MODE LOAD ONLY PROGRAMMING

MODE LOAD, ML, asserted enables an internal 23-bit programmable register. To use this method, the user asserts ML, enabling the internal programming register. After ML is asserted, a valid programming selection is placed on the address bus (and ECASO), then ML is negated. When ML is negated, the value on the address bus (and ECASO) is latched into the internal programming register and the DP8520A/21A/22A is programmed, as shown in *Figure 45*. After ML is negated, the DP8520A/21A/22A will enter the 60 ms initialization period only if this is the first programming after power up or reset.

Using this method, a set of transceivers on the address bus can be put at TRI-STATE® by the system reset signal. A combination of pull-up and pull-down resistors can be used on the address inputs of the DP8520A/21A/22A to select the programming values, as shown in *Flgure 46*.

#### 9.2 CHIP SELECTED ACCESS PROGRAMMING

The chip can also be programmed by asserting  $\overline{\text{ML}}$  and performing a chip selected access.  $\overline{\text{ADS}}$  (or ALE) is disabled internally until after programming. To program the chip using this method,  $\overline{\text{ML}}$  is asserted. After  $\overline{\text{ML}}$  is asserted,  $\overline{\text{CS}}$  is asserted and a valid programming selection is placed on the address bus. When  $\overline{\text{AREQ}}$  is asserted, the chip is programmed with the programming selection on the address bus. After  $\overline{\text{AREQ}}$  is negated,  $\overline{\text{ML}}$  can be negated as shown in *Figure 47*.



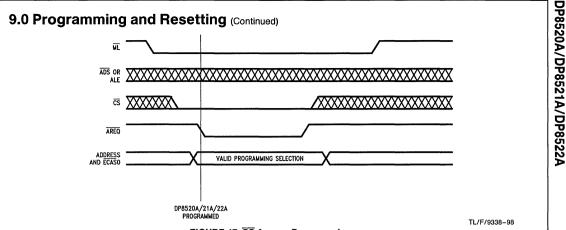
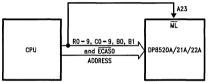


FIGURE 47. CS Access Programming

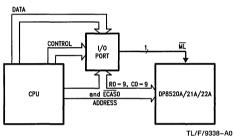
Using this method, various programming schemes can be used. For example if extra upper address bits are available, an unused high order address bit can be tied to the signal  $\overline{\text{ML}}$ . Using this method, one need only write to a page of memory, thus asserting the high order bit and in turn programming the chip as shown in *Figure 48*.



TL/F/9338-99

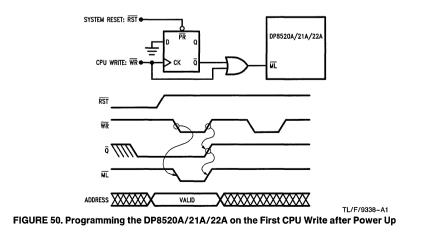
#### FIGURE 48. Programming the DP8520A/21A/22A through the Address Bus Only

An I/O port can also be used to assert  $\overline{\text{ML}}$ . After  $\overline{\text{ML}}$  is asserted, a chip selected access can be performed to program the chip. After the chip selected access,  $\overline{\text{ML}}$  can be negated through the I/O port as shown in *Figure 49*.



# FIGURE 49. Programming the DP8520A/21A/22A through the Address Bus and an I/O Port

Another simple way the chip can be programmed is the first write after system reset. This method requires only a flip-flop and an OR gate as shown in *Figure 50*. At reset, the flip-flop is preset, which pulls the  $\overline{Q}$  output low. Since  $\overline{WR}$  is negated,  $\overline{ML}$  is not enabled. The first write access is used to program the chip. When  $\overline{WR}$  is asserted,  $\overline{ML}$  is asserted.  $\overline{WR}$  negated clocks the flip-flop, negates  $\overline{ML}$ , and programs the DP8520A/21A/22A with the address and  $\overline{ECAS0}$  available at that time.  $\overline{CS}$  does not need to be asserted using this method.



### 9.0 Programming and Resetting (Continued)

#### 9.3 EXTERNAL RESET

At power up, if the internal power up reset worked, all internal latches and flip-flops are cleared. The power up state is entered by asserting  $\overline{\text{ML}}$  and  $\overline{\text{DISRFSH}}$  for 16 positive edges of CLK. After 16 clocks if the user negates  $\overline{\text{DISRFSH}}$  before negating  $\overline{\text{ML}}$  as shown in *Figure 51*,  $\overline{\text{ML}}$  negated

will program the chip. If  $\overline{\text{ML}}$  is negated before or at the same time as  $\overline{\text{DISRFSH}}$  as shown in *Figure 52*, the chip will not be programmed. After the chip is programmed, the 60 ms initialization period will be entered into if this is the first programming after power up or reset. The user <u>must</u> perform an external reset before programming the DP8520A/21A/22A.

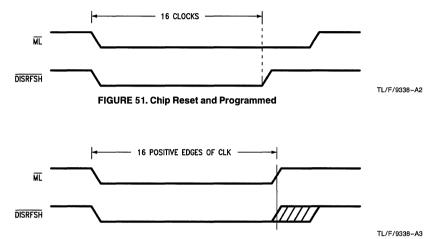


FIGURE 52. Chip Reset but Not Programmed

# 9.0 Programming and Resetting (Continued)

### 9.4 PROGRAMMING BIT DEFINITIONS

| Symbol     | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ECAS0      | Extend CAS/Refresh Request Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 0          | The $\overline{CASn}$ outputs will be negated with the $\overline{RASn}$ outputs when $\overline{AREQ}$ (or $\overline{AREQB}$ , DP8522A only) is<br>negated. The $\overline{RFIP}$ pin will function as refresh in progress. During a video shift register load operation, the<br>$\overline{DT}/\overline{OE}$ output will be negated by either the 4th rising clock edge after the input $\overline{VSRL}$ asserts, or by the<br>$\overline{VSRL}$ input negating, whichever occurs first, when this mode is programmed.                                                                                                    |
| 1          | The CASn outputs will be negated, during an access (Port A (or Port B, DP8522A only)) when their corresponding ECASn inputs are negated. This feature allows the CAS outputs to be extended beyond the RAS outputs negating. Scrubbing refreshes are NOT affected. During scrubbing refreshes the CAS outputs will negate along with the RAS outputs regardless of the state of the ECAS inputs. The RFIP output will function as ReFresh ReQuest (RFRQ) when this mode is programmed. The DT/OE output will be negated by the input VSRL negating when this mode is programmed.                                               |
| B1         | Access Mode Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 0          | ACCESS MODE 0: ALE pulsing high sets an internal latch. On the next positive edge of CLK, the access (RAS) will start. AREQ will terminate the access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 1          | ACCESS MODE 1: ADS asserted starts the access (RAS) immediately. AREQ will terminate the access.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| B0         | Address Latch Mode                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 0<br>1     | ADS or ALE asserted for Port A or AREQB asserted for Port B with the appropriate GRANT latch the input row, column and bank address.<br>The row, column and bank latches are fall through.                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| C9         | Delay CAS during WRITE Accesses                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 0          | CAS is treated the same for both READ and WRITE accesses.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 1          | During WRITE accesses, CAS will be asserted by the event that occurs last: CAS asserted by the internal delay line or CAS asserted on the positive edge of CLK after RAS is asserted.                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| C8         | Row Address Hold Time                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 0<br>1     | Row Address Hold Time = 25 ns minimum<br>Row Address Hold Time = 15 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| C7         | Column Address Setup Time                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 0<br>1     | Column Address Setup Time = 10 ns minimum<br>Column Address Setup Time = 0 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| C6, C5, C4 | RAS and CAS Configuration Modes/Error Scrubbing during Refresh                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 0, 0, 0    | RAS0-3 and CAS0-3 are all selected during an access. For a particular CAS to be asserted, its<br>corresponding ECAS input must be asserted. B0 and B1 are not used during an access. Error scrubbing<br>during refresh.                                                                                                                                                                                                                                                                                                                                                                                                        |
| 0, 0, 1    | RAS and CAS pairs are selected during an access by B1. For a particular CAS to be asserted, its<br>corresponding ECAS input must be asserted.B1 = 0 during an access selects RAS0-1 and CAS0-1.B1 = 1 during an access selects RAS2-3 and CAS2-3.B0 is not used during an Access.Error scrubbing during refresh.                                                                                                                                                                                                                                                                                                               |
| 0, 1, 0    | RAS and CAS singles are selected during an access by $B0-1$ . For a particular $\overline{CAS}$ to be asserted, its corresponding $\overline{ECAS}$ input must be asserted.<br>$B1 = 0, B0 = 0$ during an access selects $\overline{RAS}0$ and $\overline{CAS}0$ .<br>$B1 = 0, B0 = 1$ during an access selects $\overline{RAS}1$ and $\overline{CAS}1$ .<br>$B1 = 1, B0 = 0$ during an access selects $\overline{RAS}2$ and $\overline{CAS}2$ .<br>$B1 = 1, B0 = 0$ during an access selects $\overline{RAS}2$ and $\overline{CAS}2$ .<br>$B1 = 1, B0 = 1$ during an access selects $\overline{RAS}3$ and $\overline{CAS}3$ . |
| 0, 1, 1    | Error scrubbing during refresh.<br>RAS0-3 and CAS0-3 are all selected during an access. For a particular CAS to be asserted, its<br>corresponding ECAS input must be asserted.<br>B1, B0 are not used during an access.<br>No error scrubbing. (RAS only refreshing)                                                                                                                                                                                                                                                                                                                                                           |

1

# 9.0 Programming and Resetting (Continued) 9.4 PROGRAMMING BIT DEFINITIONS (Continued)

| Symbol                                                                               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|--------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C6, C5, C4                                                                           | RAS and CAS Configuration Modes (Continued)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 1, 0, 0<br>1, 0, 1                                                                   | RAS pairs are selected by B1. CAS0-3 are all selected. For a particular CAS to be asserted, its corresponding ECAS input must be asserted.         B1 = 0 during an access selects RAS0-1 and CAS0-3.         B1 = 1 during an access selects RAS2-3 and CAS0-3.         B0 is not used during an access.         No error scrubbing.         RAS and CAS pairs are selected by B1. For a particular CAS to be asserted, its corresponding ECAS input must be asserted.                                                                                                                                               |
|                                                                                      | must be asserted.<br>$B1 = 0$ during an access selects $\overline{RAS}0-1$ and $\overline{CAS}0-1$ .<br>$B1 = 1$ during an access selects $\overline{RAS}2-3$ and $\overline{CAS}2-3$ .<br>B0 is not used during an access.<br>No error scrubbing.                                                                                                                                                                                                                                                                                                                                                                    |
| 1, 1, 0                                                                              | <ul> <li>RAS singles are selected by B0-1. CAS0-3 are all selected. For a particular CAS to be asserted, its corresponding ECAS input must be asserted.</li> <li>B1 = 0, B0 = 0 during an access selects RAS0 and CAS0-3.</li> <li>B1 = 0, B0 = 1 during an access selects RAS1 and CAS0-3.</li> <li>B1 = 1, B0 = 0 during an access selects RAS2 and CAS0-3.</li> <li>B1 = 1, B0 = 1 during an access selects RAS3 and CAS0-3.</li> <li>B1 = 1, B0 = 1 during an access selects RAS3 and CAS0-3.</li> <li>B1 = 1, B0 = 1 during an access selects RAS3 and CAS0-3.</li> </ul>                                        |
| 1, 1, 1                                                                              | RAS and CAS singles are selected by B0, 1. For a particular CAS to be asserted, its corresponding ECASinput must be asserted. $B1 = 0, B0 = 0$ during an access selects RAS0 and CAS0. $B1 = 0, B0 = 1$ during an access selects RAS1 and CAS1. $B1 = 1, B0 = 0$ during an access selects RAS2 and CAS2. $B1 = 1, B0 = 1$ during an access selects RAS3 and CAS3.No error scrubbing.                                                                                                                                                                                                                                  |
| СЗ                                                                                   | Refresh Clock Fine Tune Divisor                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 0                                                                                    | Divide delay line/refresh clock further by 30 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 15 $\mu$ s refresh period).<br>Divide delay line/refresh clock further by 26 (If DELCLK/Refresh Clock Clock Divisor = 2 MHz = 13 $\mu$ s refresh period).                                                                                                                                                                                                                                                                                                                                                              |
| C2, C1, C0                                                                           | Delay Line/Refresh Clock Divisor Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 0, 0, 0<br>0, 0, 1<br>0, 1, 0<br>0, 1, 1<br>1, 0, 0<br>1, 0, 1<br>1, 1, 0<br>1, 1, 1 | Divide DELCLK by 10 to get as close to 2 MHz as possible.<br>Divide DELCLK by 9 to get as close to 2 MHz as possible.<br>Divide DELCLK by 8 to get as close to 2 MHz as possible.<br>Divide DELCLK by 7 to get as close to 2 MHz as possible.<br>Divide DELCLK by 6 to get as close to 2 MHz as possible.<br>Divide DELCLK by 5 to get as close to 2 MHz as possible.<br>Divide DELCLK by 5 to get as close to 2 MHz as possible.<br>Divide DELCLK by 5 to get as close to 2 MHz as possible.<br>Divide DELCLK by 4 to get as close to 2 MHz as possible.<br>Divide DELCLK by 3 to get as close to 2 MHz as possible. |
| R9                                                                                   | Refresh Mode Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 0<br>1                                                                               | RAS0-3 will all assert and negate at the same time during a refresh.<br>Staggered Refresh. RAS outputs during refresh are separated by one positive clock edge. Depending on the configuration mode chosen, either one or two RASs will be asserted.                                                                                                                                                                                                                                                                                                                                                                  |
| R8                                                                                   | Address Pipelining Select                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 0                                                                                    | Address pipelining is selected. The VRAM controller will switch the VRAM column address back to the row<br>address after guaranteeing the column address hold time.                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 1                                                                                    | Non-address pipelining is selected. The VRAM controller will hold the column address on the VRAM address bus until the access RASs are negated.                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |

# 9.0 Programming and Resetting (Continued)

9.4 PROGRAMMING BIT DEFINITIONS (Continued)

| Symbol | Description                                                                                                                                                                                                                                                                                                                                                                                          |
|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R7     | WAIT or DTACK Select                                                                                                                                                                                                                                                                                                                                                                                 |
| 0<br>1 | WAIT type output is selected.<br>DTACK (Data Transfer ACKnowledge) type output is selected.                                                                                                                                                                                                                                                                                                          |
| R6     | Add Wait States to the Current Access if WAITIN is Low                                                                                                                                                                                                                                                                                                                                               |
| 0<br>1 | WAIT or DTACK will be delayed by one additional positive edge of CLK.<br>WAIT or DTACK will be delayed by two additional positive edges of CLK.                                                                                                                                                                                                                                                      |
| R5, R4 | WAIT/DTACK during Burst (See Section 5.1.2 or 5.2.2)                                                                                                                                                                                                                                                                                                                                                 |
| 0, 0   | NO WAIT STATES; If $R7 = 0$ during programming, WAIT will remain negated during burst portion of access.<br>If $R7 = 1$ programming, DTACK will remain asserted during burst portion of access.                                                                                                                                                                                                      |
| 0, 1   | 1T; If $R7 = 0$ during programming, WAIT will assert when the ECAS inputs are negated with AREQ asserted.<br>WAIT will negate from the positive edge of CLK after the ECASs have been asserted.<br>If $R7 = 1$ during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted.<br>DTACK will assert from the positive edge of CLK after the ECASs have been asserted.     |
| 1, 0   | $\frac{1}{2}$ T; If R7 = 0 during programming, WAIT will assert when the ECAS inputs are negated with AREQ asserted. WAIT will negate on the negative level of CLK after the ECAS have been asserted.<br>If R7 = 1 during programming, DTACK will negate when the ECAS inputs are negated with AREQ asserted.<br>DTACK will assert from the negative level of CLK after the ECAS have been asserted. |
| 1, 1   | 0T; If $R7 = 0$ during programming, WAIT will assert when the ECAS inputs are negated. WAIT will negate when the ECAS inputs are asserted.<br>If $R7 = 1$ during programming, DTACK will negate when the ECAS inputs are negated. DTACK will assert when the ECAS inputs are asserted.                                                                                                               |
| R3, R2 | WAIT/DTACK Delay Times (See Section 5.1.1 or 5.2.1)                                                                                                                                                                                                                                                                                                                                                  |
| 0, 0   | NO WAIT STATES; If $R7 = 0$ during programming, WAIT will remain high during non-delayed accesses.<br>WAIT will negate when RAS is negated during delayed accesses.<br>NO WAIT STATES; If $R7 = 1$ during programming, DTACK will be asserted when RAS is asserted.                                                                                                                                  |
| 0, 1   | $\frac{1}{2}$ T; If R7 = 0 during programming, WAIT will negate on the negative level of CLK, after the access RAS.<br>1T; If R7 = 1 during programming, DTACK will be asserted on the positive edge of CLK after the access RAS.<br>RAS.                                                                                                                                                            |
| 1, 0   | NO WAIT STATES, $\frac{1}{2}$ T; If R7 = 0 during programming, WAIT will remain high during non-delayed accesses.<br>WAIT will negate on the negative level of CLK, after the access RAS, during delayed accesses.<br>$\frac{1}{2}$ T; If R7 = 1 during programming, DTACK will be asserted on the negative level of CLK after the access RAS.                                                       |
| 1, 1   | 1T; If $R7 = 0$ during programming, WAIT will negate on the positive edge of CLK after the access RAS.<br>1½T; If $R7 = 1$ during programming, DTACK will be asserted on the negative level of CLK after the positive edge of CLK after the access RAS.                                                                                                                                              |
| R1, R0 | RAS Low and RAS Precharge Time                                                                                                                                                                                                                                                                                                                                                                       |
| 0, 0   | $\overline{\text{RAS}}$ asserted during refresh = 2 positive edges of CLK.<br>$\overline{\text{RAS}}$ precharge time = 1 positive edge of CLK.<br>$\overline{\text{RAS}}$ will start from the first positive edge of CLK after GRANTB transitions (DP8522A).                                                                                                                                         |
| 0, 1   | $\overline{RAS}$ asserted during refresh = 3 positive edges of CLK.<br>$\overline{RAS}$ precharge time = 2 positive edges of CLK.<br>$\overline{RAS}$ will start from the second positive edge of CLK after GRANTB transitions (DP8522A).                                                                                                                                                            |
| 1, 0   | $\overline{RAS}$ asserted during refresh = 2 positive edges of CLK.<br>$\overline{RAS}$ precharge time = 2 positive edges of CLK.<br>$\overline{RAS}$ will start from the first positive edge of CLK after GRANTB transitions (DP8522A).                                                                                                                                                             |
| 1, 1   | $\overline{RAS}$ asserted during refresh = 4 positive edges of CLK.<br>$\overline{RAS}$ precharge time = 3 positive edges of CLK.<br>$\overline{RAS}$ will start from the second positive edge of CLK after GRANTB transitions (DP8522A).                                                                                                                                                            |

Note 1: The configuration modes allow RASs and CASs to be grouped such that each RAS and CAS will drive one-fourth of the total VRAM array whether the array is organized as 1, 2, or 4 banks.

Note 2: In order for a CAS output to go low during an access, it must be both selected and enabled. ECAS0-1 are used to enable the CAS outputs (ECAS0 enables CAS0,1; ECAS1 enables CAS2,3). Selection is determined by the configuration mode and B1, B0.

# 10.0 Test Mode

Staggered refresh in combination with the error scrubbing mode places the DP8520A/21A/22A in test mode. In this mode, the 24-bit refresh counter is divided into a 13-bit and 11-bit counter. During refreshes both counters are incremented to reduce test time.

# 11.0 VRAM Critical Timing Parameters

The two critical timing parameters, shown in *Figure 53*, that must be met when controlling the access timing to a VRAM are the row address hold time, tRAH, and the column address setup time, tASC. Since the DP8520A/21A/22A contain a precise internal delay line, the values of these parameters can be selected at programming time. These values will also increase and decrease if DELCLK varies from 2 MHz.

### 11.1 PROGRAMMABLE VALUES OF tRAH AND tASC

The DP8520A/21A/22A allow the values of tRAH and tASC to be selected at programming time. For each parameter, two choices can be selected. tRAH, the row address hold time, is measured from RAS asserted to the row address starting to change to the column address. The two choices for tRAH are 15 ns and 25 ns, programmable through address bit C8.

tASC, the column address setup time, is measured from the column address valid to  $\overline{CAS}$  asserted. The two choices for tASC are 0 ns and 10 ns, programmable through address bit C7.

### 11.2 CALCULATION OF tRAH AND tASC

There are two clock inputs to the DP8520A/21A/22A. These two clocks, DELCLK and CLK can either be tied together to the same clock or be tied to different clocks running asynchronously at different frequencies.

The clock input, DELCLK, controls the internal delay line and refresh request clock. DELCLK should be a multiple of 2 MHz. If DELCLK is not a multiple of 2 MHz, tRAH and tASC will change. The new values of tRAH and tASC can be calculated by the following formulas:

If tRAH was programmed to equal 15 ns then tRAH =  $30^{*}(((DELCLK Divisor)^{*} 2 MHz/(DELCLK Frequency)) - 1) + 15 ns.$ 

If tRAH was programmed to equal 25 ns then tRAH = 30\*(((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency))-1) + 25 ns.

If tASC was programmed to equal 0 ns then tASC =  $15^*$  ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 15 ns.

If tASC was programmed to equal 10 ns then tASC =  $25^{*}$  ((DELCLK Divisor)\* 2 MHz/(DELCLK Frequency)) - 15 ns. Since the values of tRAH and tASC are increased or decreased, the time to CAS asserted will also increase or decrease. These parameters can be adjusted by the following formula:

Delay to  $\overline{CAS}$  = Actual Spec. + Actual tRAH -

Programmed tRAH + Actual tASC – Programmed tASC.

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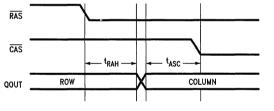


FIGURE 53. tRAH and tASC

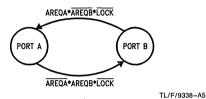
# 12.0 Dual Accessing Functions (DP8522A)

The DP8522A has all the functions previously described. In addition to those features, the DP8522A also has the capabilities to arbitrate among refresh, Port A and a second port, Port B. This allows two CPUs to access a common VRAM array. VRAM refresh has the highest priority followed by the currently granted port. The ungranted port has the lowest priority. The last granted port will continue to stay granted even after the access has terminated, until an access request is received from the ungranted port (see *Figure 54a*). The dual access configuration assumes that both Port A and Port B are synchronous to the system clock. If they are not synchronized (Ex. By running the access requests through several Flip-Flops, see *Figure 58a*).

#### 12.1 PORT B ACCESS MODES (DP8522A)

Port B accesses are initiated from a single input, AREQB. When AREQB is asserted, an access request is generated. If GRANTB is asserted and a refresh is not taking place or precharge time is not required, RAS will be asserted when AREQB is asserted. Once AREQB is asserted, it must stay asserted until the access is over. AREQB negated, negates RAS as shown in *Figure 54b*. Note that if ECAS0 = 1 during programming the CAS outputs may be held asserted (beyond RASn negating) by continuing to assert the appropriate ECAS input (the same as Port A accesses). If Port B is not granted, the access will begin on the first or second positive edge of CLK after GRANTB is asserted (See R0, R1 programming bit definitions) as shown in *Figure 54c*, as suming that Port A is not accessing the VRAM ( $\overline{CS}$ ,  $\overline{ADS}$ /ALE and  $\overline{AREQ}$ ) and  $\overline{RAS}$  precharge for the particular bank has completed. It is important to note that for GRANTB to transition to Port B, Port A must **not** be requesting an access at a rising clock edge (or locked) and Port B must be requesting an access at that rising clock edge. Port A can request an access through  $\overline{CS}$  and  $\overline{ADS}/ALE$  or  $\overline{CS}$  and  $\overline{AREQ}$ . Therefore during an interleaved access where  $\overline{CS}$ and  $\overline{ADS}/ALE$  become asserted before  $\overline{AREQ}$  from the previous access is negated, Port A will retain GRANTB = 0 whether  $\overline{AREQB}$  is asserted or not.

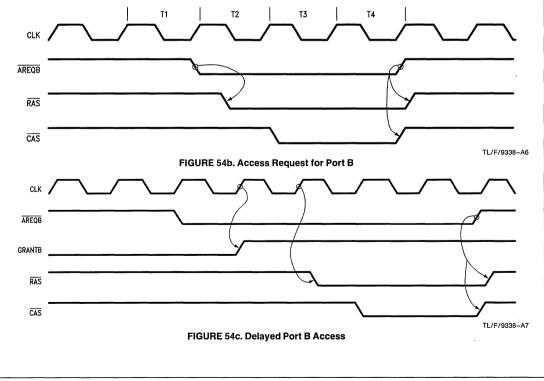
Since there is no chip select for Port B, AREQB must incorporate this signal. This mode of accessing is similar to Mode 1 accessing for Port A.



Explanation of Terms

- AREQA = Chip Selected access request from Port A
- AREQB = Chip Selected access request from Port B
- LOCK = Externally controlled LOCKing of the Port
- that is currently GRANTed.

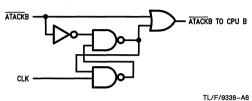
FIGURE 54a. DP8522A PORT A/PORT B ARBITRATION STATE DIAGRAM. This arbitration may take place during the "ACCESS" or "REFRESH" state (see *Figure 7a* ).



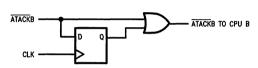
# 12.0 Dual Accessing Functions (DP8522A) (Continued)

#### 12.2 PORT B WAIT STATE SUPPORT (DP8522A)

Advanced transfer acknowledge for Port B,  $\overline{\text{ATACKB}}$ , is used for wait state support for Port B. This output will be asserted when RAS for the Port B access is asserted, as shown in *Figures 55* and *56*. Once asserted, this output will stay asserted until  $\overline{\text{AREOB}}$  is negated. With external logic,  $\overline{\text{ATACKB}}$  can be made to interface to any CPU's wait input as shown in *Figure 57*.

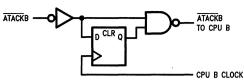


A) Extend ATACK to 1/2T (1/2 Clock) after RAS goes low.



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B) Extend ATACK to 1T after RAS goes low.



TL/F/9338-B0

C) Synchronize ATACKB to CPU B Clock. This is useful if CPU B runs asynchronous to the DP8522.

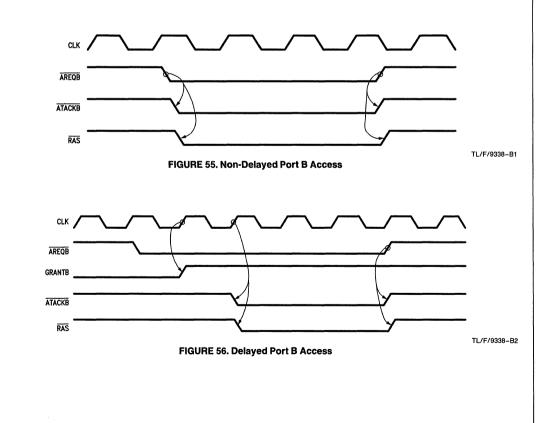
#### FIGURE 57. Modifying Wait Logic for Port B

#### 12.3 COMMON PORT A AND PORT B DUAL PORT FUNCTIONS

An input, LOCK, and an output, GRANTB, add additional functionality to the dual port arbitration logic. LOCK allows Port A or Port B to lock out the other port from the VRAM. When a Port is locked out of the VRAM, wait states will be inserted into its access cycle until it is allowed to access memory. GRANTB is used to multiplex the input control signals and addresses to the DP8522A.

#### 12.3.1 GRANTB Output

The output GRANTB determines which port has current access to the VRAM array. GRANTB asserted signifies Port B has access. GRANTB negated signifies Port A has access to the VRAM array.



# 12.0 Dual Accessing Functions (DP8522A) (Continued)

Since the DP8522A has only one set of address inputs, the signal is used, with the addition of buffers, to allow the currently granted port's addresses to reach the DP8522A. The signals which need to be bufferred are R0-10, C0-10, B0-1, ECAS0-1, and LOCK. All other inputs are not common and do not have to be buffered as shown in *Figure 58a*. If a Port, which is not currently granted, tries to access

the VRAM array, the GRANTB output will transition from a rising clock edge from  $\overline{AREQ}$  or  $\overline{AREQB}$  negating and will preceed the RAS for the access by one or two clock periods. GRANTB will then stay in this state until the other port requests an access and the currently granted port is not accessing the VRAM as shown in *Figure 58b*.

#### Dual Accessing Using the DP8522A PORT R PORT A (SYNCHRONOUS OR (SYNCHRONOUS) ASYNCHRONOUS) сгоск CLOCK CLK, DLV CLK CLOCKS VSRL, AVSRLRQ REQUEST AND CONTROL CONTROL CONTRO CONTROL CONTROL SYNCHRONIZING WAIT WAIT LOGIC (PAL) WAIT LOGIC \* WAIT GRAPHICS WE, LOCK ENB O PROCESSOR DP8522A WE, LOCK СРυ ADDRESS, WE, LOCK (OR TRI - STATE BUFFERS CONVENTIONA ADDRES O ENA CPU) GRANTE ► ENB TRI – STATE ADDRESS ADDRESS BUFFERS ADDRESS, RASO - 3, TO COLOR LOOKUP TABLE, PLANE CONTROL, WE DIGITAL - ANALOG CONVERTERS AND CRT CAS0 - 3. DT/OE N - PLANES (BANKS) of VIDEO RAMS SHIFT CLOCK FOR VIDEO DRAM (May also contain conventional DRAMS) PIXEL CLOCK FOR VIDEO SHIFT REGISTER DIR, CS, DBE DIR, CS, DBE ENB D DATA BUS DAT/ BUIS DATA BUS TL/F/9338-1

\*If Port B is synchronous the Request Synchronizing logic will not be required.

FIGURE 58a. Dual Accessing Using the DP8522A to interface a CPU and a Graphics Processor to a Video RAM System

DP8520A/DP8521A/DP8522A

1

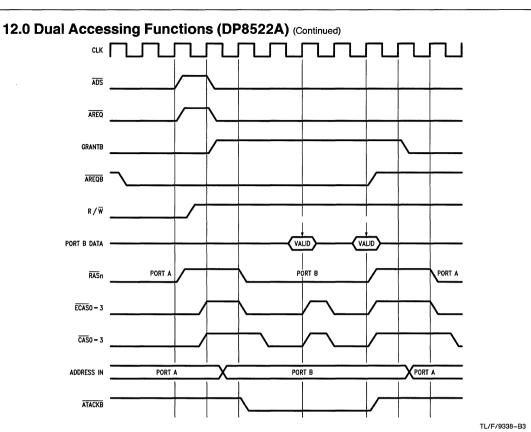


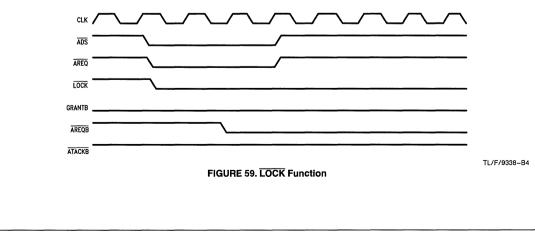
FIGURE 58b. Wait States during a Port B Access

#### 12.3.2 LOCK Input

When the  $\overline{\text{LOCK}}$  input is asserted, the currently granted port can "lock out" the other port through the insertion of wait states to that port's access cycle.  $\overline{\text{LOCK}}$  does not disable refreshes, it only keeps GRANTB in the same state even if the other port requests an access, as shown in *Figure 59*.  $\overline{\text{LOCK}}$  can be used by either port. The user must guarantee that  $\overline{\text{LOCK}}$  is not asserted with Port B granted when  $\overline{\text{AVSRLRQ}}$  is asserted to request a VRAM transfer cycle.

#### **12.4 DUAL PORTING AND VRAM TRANSFER CYCLES**

The input AVSRLRQ disables any further internally or externally requested refreshes or Port B access requests from being executed. The AVSRLRQ input does this by making the VRAM controller arbitration logic think that a Port A access is in progress from the point where the AVSRLRQ input goes low until the VRAM shift register load operation is completed.



# 13.0 Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications. Storage Temperature .....-65°C to +150°C

ESD Rating to be determined.

| 14.0 DC Electrical Characteristics T <sub>4</sub> | $A = 0^{\circ}$ C to +70°C, $V_{CC} = 5V \pm 10^{\circ}$ , GND = 0V |
|---------------------------------------------------|---------------------------------------------------------------------|
|---------------------------------------------------|---------------------------------------------------------------------|

| Symbol           | Parameter                     | Conditions                                                                      | Min                   | Тур | Max                   | Units |
|------------------|-------------------------------|---------------------------------------------------------------------------------|-----------------------|-----|-----------------------|-------|
| VIH              | Logical 1 Input Voltage       | Tested with a Limited<br>Functional Pattern                                     | 2.0                   |     | V <sub>CC</sub> + 0.5 | v     |
| VIL              | Logical 0 Input Voltage       | Tested with a Limited<br>Functional Pattern                                     | -0.5                  |     | 0.8                   | v     |
| V <sub>OH1</sub> | Q and $\overline{WE}$ Outputs | $I_{OH} = -10 \text{ mA}$                                                       | V <sub>CC</sub> - 1.0 |     |                       | v     |
| V <sub>OL1</sub> | Q and $\overline{WE}$ Outputs | I <sub>OL</sub> = 10 mA                                                         |                       |     | 0.5                   | v     |
| V <sub>OH2</sub> | All Outputs except Qs, WE     | $I_{OH} = -3 \text{ mA}$                                                        | V <sub>CC</sub> - 1.0 |     |                       | V     |
| V <sub>OL2</sub> | All Outputs except Qs, WE     | $I_{OL} = 3 \text{ mA}$                                                         |                       |     | 0.5                   | v     |
| I <sub>IN</sub>  | Input Leakage Current         | $V_{IN} = V_{CC} \text{ or } GND$                                               | -10                   |     | 10                    | μA    |
| IIL ML           | ML Input Current (Low)        | $V_{IN} = GND$                                                                  |                       |     | 200                   | μΑ    |
| I <sub>CC1</sub> | Standby Current               | CLK at 8 MHz ( $V_{IN} = V_{CC}$ or GND)                                        |                       | 6   | 15                    | mA    |
| ICC1             | Standby Current               | CLK at 20 MHz ( $V_{IN} = V_{CC}$ or GND)                                       |                       | 8   | 17                    | mA    |
| I <sub>CC1</sub> | Standby Current               | CLK at 25 MHz ( $V_{IN} = V_{CC}$ or GND)                                       |                       | 10  | 20                    | mA    |
| I <sub>CC2</sub> | Supply Current                | CLK at 8 MHz (Inputs Active) $(I_{LOAD} = 0) (V_{IN} = V_{CC} \text{ or GND})$  |                       | 20  | 40                    | mA    |
| I <sub>CC2</sub> | Supply Current                | CLK at 20 MHz (Inputs Active)<br>( $I_{LOAD} = 0$ ) ( $V_{IN} = V_{CC}$ or GND) |                       | 40  | 75                    | mA    |
| I <sub>CC2</sub> | Supply Current                | CLK at 25 MHz (Inputs Active)<br>( $I_{LOAD} = 0$ ) ( $V_{IN} = V_{CC}$ or GND) |                       | 50  | 95                    | mA    |
| CIN*             | Input Capacitance             | f <sub>IN</sub> at 1 MHz                                                        |                       |     | 10                    | pF    |

\*Note: CIN is not 100% tested.

# 15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A

Two speed selections are given, the DP8520A/21A/22A-20 and the DP8520A/21A/22A-25. The differences between the two parts are the maximum operating frequencies of the input CLKs and the maximum delay specifications. Low frequency applications may use the "-25" part to gain improved timing.

The AC timing parameters are grouped into sectional numbers as shown below. These numbers also refer to the timing diagrams.

1-38 Common parameters to all modes of operation

50-56 Difference parameters used to calculate;

RAS low time,

- RAS precharge time,
- CAS high time and
- CAS low time
- 100-121 Common dual access parameters used for Port B accesses and inputs and outputs used only in dual accessing
- 200-212 Refresh parameters

- 300-315 Mode 0 access parameters used in both single and dual access applications
- 400-416 Mode 1 access parameters used in both single and dual access applications
- 450-455 Special Mode 1 access parameters which supersede the 400-416 parameters when dual accessing
- 500-506 Programming parameters

600–605 Graphics parameters for VRAM transfer cycles Unless otherwise stated  $V_{CC}=5.0V\pm10\%$ , 0 < T<sub>A</sub> < 70°C, the output load capacitance is typical for 4 banks of 18 VRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except
- $C_L = 150 \text{ pF}$  loads on Q0–8, 9, and 10; or
- $C_H = 50 \text{ pF}$  loads on all outputs except
- $C_{H} = 125 \text{ pF}$  loads on  $\overline{RAS0}-3$  and  $\overline{CAS0}-3$  and
- $C_H = 380 \text{ pF}$  loads on Q0-8, 9, and 10.

|        |                 | Common Parameter<br>Description                                                                       | 8   | 520A/21 | A/22A- | 20  | 8520A/21A/22A-25 |     |    |     |  |
|--------|-----------------|-------------------------------------------------------------------------------------------------------|-----|---------|--------|-----|------------------|-----|----|-----|--|
| Number | Symbol          |                                                                                                       | CL  |         | Сн     |     | CL               |     | C  | ≻н  |  |
|        |                 | Description                                                                                           | Min | Max     | Min    | Max | Min              | Max |    | Max |  |
| 1      | fCLK            | CLK Frequency                                                                                         | 0   | 20      | 0      | 20  | 0                | 25  | 0  | 25  |  |
| 2      | tCLKP           | CLK Period                                                                                            | 50  |         | 50     |     | 40               |     | 40 |     |  |
| 3, 4   | tCLKPW          | CLK Pulse Width                                                                                       | 15  |         | 15     |     | 12               |     | 12 |     |  |
| 5      | fDCLK           | DELCLK Frequency                                                                                      | 5   | 20      | 5      | 20  | 5                | 20  | 5  | 20  |  |
| 6      | tDCLKP          | DELCLK Period                                                                                         | 50  | 200     | 50     | 200 | 50               | 200 | 50 | 200 |  |
| 7, 8   | tDCLKPW         | DELCLK Pulse Width                                                                                    | 15  |         | 15     |     | 12               |     | 12 |     |  |
| 9a     | tPRASCAS0       | $\overline{\text{RAS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)   | 30  |         | 30     |     | 30               |     | 30 |     |  |
| 9b     | tPRASCAS1       | $\overline{\text{RAS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)  | 40  |         | 40     |     | 40               |     | 40 |     |  |
| 9c     | tPRASCAS2       | ( $\overline{\text{RAS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns) | 40  |         | 40     |     | 40               |     | 40 |     |  |
| 9d     | tPRASCAS3       | ( $\overline{RAS}$ Asserted to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)              | 50  |         | 50     |     | 50               |     | 50 |     |  |
| 10a    | tRAH            | Row Address Hold Time (tRAH = $15$ )                                                                  | 15  |         | 15     |     | 15               |     | 15 |     |  |
| 10b    | tRAH            | Row Address Hold Time (tRAH = $25$ )                                                                  | 25  |         | 25     |     | 25               |     | 25 |     |  |
| 11a    | tASC            | Column Address Setup Time (tASC = $0$ )                                                               | 0   |         | 0      |     | 0                |     | 0  |     |  |
| 11b    | tASC            | Column Address Setup Time (tASC = $10$ )                                                              | 10  |         | 10     |     | 10               |     | 10 |     |  |
| 12     | tPĊKRAS         | CLK High to RAS Asserted following Precharge                                                          |     | 27      |        | 32  |                  | 22  |    | 26  |  |
| 13     | <b>tPARQRAS</b> | AREQ Negated to RAS Negated                                                                           |     | 38      |        | 43  |                  | 31  |    | 35  |  |
| 14     | tPENCL          | ECAS0-1 Asserted to CAS Asserted                                                                      |     | 23      |        | 31  |                  | 20  |    | 27  |  |
| 15     | tPENCH          | ECAS0-1 Negated to CAS Negated                                                                        |     | 25      |        | 33  |                  | 20  |    | 27  |  |
| 16     | tPARQCAS        | AREQ Negated to CAS Negated                                                                           |     | 60      |        | 68  |                  | 47  |    | 54  |  |
| 17     | tPCLKWH         | CLK to WAIT Negated                                                                                   |     | 39      |        | 39  |                  | 31  |    | 31  |  |
| 18     | tPCLKDL0        | CLK to DTACK Asserted<br>(Programmed as DTACK of 1/2, 1, 1½<br>or if WAITIN is Asserted)              |     | 33      |        | 33  |                  | 28  |    | 28  |  |
| 19     | tPEWL           | ECAS Negated to WAIT Asserted during a Burst Access                                                   |     | 42      |        | 42  |                  | 34  |    | 34  |  |
| 20     | tSECK           | ECAS Asserted Setup to CLK High to<br>Recognize the Rising Edge of CLK<br>during a Burst Access       | 24  |         | 24     |     | 19               |     | 19 |     |  |

**15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 VRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except
- $C_L = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0-3 and CAS0-3 and  $C_H=380$  pF loads on Q0-8, 9 and 10.

|        |          |                                                                                           | 8520A/21A/22A-20 |     |     |                | 8520A/21A/22A-25 |     |     |     |  |
|--------|----------|-------------------------------------------------------------------------------------------|------------------|-----|-----|----------------|------------------|-----|-----|-----|--|
| Number | Symbol   | Common Parameter<br>Description                                                           | CL               |     | C   | С <sub>Н</sub> |                  | CL  |     | Я   |  |
|        |          |                                                                                           | Min              | Max | Min | Max            | Min              | Max | Min | Max |  |
| 21     | tPEDL    | ECAS Asserted to DTACK<br>Asserted during a Burst Access<br>(Programmed as DTACK0)        |                  | 48  |     | 48             |                  | 38  |     | 38  |  |
| 22     | tPEDH    | ECAS Negated to DTACK<br>Negated during a Burst Access                                    |                  | 49  |     | 49             |                  | 38  |     | 38  |  |
| 23     | tSWCK    | WAITIN Asserted Setup to CLK                                                              | 5                |     | 5   |                | 5                |     | 5   |     |  |
| 26     | tPAQ     | Row, Column Address Valid to<br>Q0–8, 9, 10 Valid                                         |                  | 29  |     | 38             |                  | 26  |     | 35  |  |
| 27     | tPCINCQ  | COLINC Asserted to Q0-8, 9, 10<br>Incremented                                             |                  | 34  |     | 43             |                  | 30  |     | 39  |  |
| 28     | tSCINEN  | COLINC Asserted Setup to $\overline{\text{ECAS}}$<br>Asserted to Ensure tASC = 0 ns       | 16               |     | 17  |                | 15               |     | 17  |     |  |
| 29a    | tSARQCK1 | AREQ Negated Setup to CLK<br>High with 1 Period of Precharge                              | 43               |     | 43  |                | 34               | ;   | 34  |     |  |
| 29b    | tSARQCK2 | AREQ Negated Setup to CLK High with<br>> 1 Period of Precharge Programmed                 | 19               |     | 19  |                | 15               |     | 15  |     |  |
| 30     | tPAREQDH | AREQ Negated to DTACK Negated                                                             |                  | 34  |     | 34             |                  | 27  |     | 27  |  |
| 31     | tPCKCAS  | CLK High to CAS Asserted when Delayed by WIN                                              |                  | 31  |     | 39             |                  | 25  |     | 32  |  |
| 32     | tSCADEN  | Column Address Setup to $\overline{\text{ECAS}}$<br>Asserted to Guarantee tASC = 0        | 14               |     | 15  |                | 14               |     | 16  |     |  |
| 33     | tWCINC   | COLINC Pulse Width                                                                        | 20               |     | 20  |                | 20               |     | 20  |     |  |
| 34a    | tPCKCL0  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 15 ns, tASC = 0 ns)  |                  | 81  |     | 89             |                  | 72  |     | 79  |  |
| 34b    | tPCKCL1  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 0 ns)  |                  | 91  |     | 99             |                  | 82  |     | 89  |  |
| 34c    | tPCKCL2  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 0 ns)  |                  | 91  |     | 99             |                  | 82  |     | 89  |  |
| 34d    | tPCKCL3  | CLK High to $\overline{CAS}$ Asserted following<br>Precharge (tRAH = 25 ns, tASC = 10 ns) |                  | 101 |     | 109            |                  | 92  |     | 99  |  |
| 35     | tCAH     | Column Address Hold Time<br>(Interleave Mode Only)                                        | 32               |     | 32  |                | 32               |     | 32  |     |  |
| 36     | tPCQR    | CAS Asserted to Row Address<br>Valid (Interleave Mode Only)                               |                  | 90  |     | 90             |                  | 90  |     | 90  |  |
| 37     | tPCASDTH | CAS Asserted to DT/OE<br>Asserted for a VRAM Read Access                                  |                  | 15  |     | 25             |                  | 14  |     | 24  |  |
| 38     | tPCASDTL | CAS Negated to DT/OE<br>Negated for a VRAM Read Access                                    |                  | 15  |     | 25             |                  | 14  |     | 24  |  |

**15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 VRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0-3 and CAS0-3 and  $C_H=380$  pF loads on Q0-8, 9 and 10.

|        |        | Difference<br>Parameter Description                                                | 8   | 520A/21 | A/22A-2        | 20  | 8520A/21A/22A-25 |     |     |     |  |
|--------|--------|------------------------------------------------------------------------------------|-----|---------|----------------|-----|------------------|-----|-----|-----|--|
| Number | Symbol |                                                                                    | CL  |         | C <sub>H</sub> |     | CL               |     | C   | н   |  |
|        |        |                                                                                    | Min | Max     | Min            | Max | Min              | Max | Min | Max |  |
| 50     | tD1    | (AREQ or AREQB Negated to RAS<br>Negated) Minus (CLK High to RAS<br>Asserted)      |     | 16      |                | 16  |                  | 14  |     | 14  |  |
| 51     | tD2    | (CLK High to Refresh RAS Negated)<br>Minus (CLK High to RAS Asserted)              |     | 13      |                | 13  |                  | 11  |     | 11  |  |
| 52     | tD3a   | (ADS Asserted to RAS Asserted<br>(Mode 1)) Minus (AREQ Negated<br>to RAS Negated)  |     | 4       |                | 4   |                  | 4   |     | 4   |  |
| 53     | tD3b   | (CLK High to RAS Asserted (Mode 0))<br>Minus (AREQ Negated to RAS Negated)         |     | 4       |                | 4   |                  | 4   |     | 4   |  |
| 54     | tD4    | (ECAS Asserted to CAS Asserted)<br>Minus (ECAS Negated to CAS Negated)             | -7  | 7       | -7             | 7   | -7               | 7   | -7  | 7   |  |
| 55     | tD5    | (CLK to Refresh RAS Asserted) Minus<br>(CLK to Refresh RAS Negated)                |     | 5       |                | 5   |                  | 5   |     | 5   |  |
| 56     | tD6    | (AREQ Negated to RAS Negated)<br>Minus (ADS Asserted to RAS<br>Asserted ((Mode 1)) |     | 12      |                | 12  |                  | 10  |     | 10  |  |

# 15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A (Continued)

Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C < T<sub>A</sub> < 70°C, the output load capacitance is typical for 4 banks of 18 VRAMs per bank, including trace capacitance (see Note 2).

- $C_L = 50 \text{ pF}$  loads on all outputs except
- $C_{L} = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

- $C_H = 50 \text{ pF}$  loads on all outputs except
- $C_{H}$  = 125 pF loads on  $\overline{RAS}0\text{--}3$  and  $\overline{CAS}0\text{--}3$  and

 $C_{H} = 380 \text{ pF}$  loads on Q0-8, 9 and 10.

|        |                  |                                                                                                                 | 8   | 520A/21 | A/22A- | ·20 | 8520A/21A/22A-25 |     |     |     |
|--------|------------------|-----------------------------------------------------------------------------------------------------------------|-----|---------|--------|-----|------------------|-----|-----|-----|
| Number | Symbol           | Common Dual Access<br>Parameter Description                                                                     |     | CL      | 0      | н   |                  | CL  | C   | н   |
|        |                  |                                                                                                                 | Min | Max     | Min    | Max | Min              | Max | Min | Max |
| 100    | tHCKARQB         | AREQB Negated Held from CLK High                                                                                | 3   |         | 3      |     | 3                |     | 3   |     |
| 101    | tSARQBCK         | AREQB Asserted Setup to CLK High                                                                                | 8   |         | 8      |     | 7                |     | 7   |     |
| 102    | tPAQBRASL        | AREQB Asserted to RAS Asserted                                                                                  |     | 37      |        | 42  |                  | 30  |     | 34  |
| 103    | tPAQBRASH        | AREQB Negated to RAS Negated                                                                                    |     | 37      |        | 42  |                  | 29  |     | 33  |
| 105    | tPCKRASG         | CLK High to RAS Asserted for<br>Pending Port B Access                                                           |     | 48      |        | 53  |                  | 38  |     | 42  |
| 106    | tPAQBATKBL       | AREQB Asserted to ATACKB Asserted                                                                               |     | 48      |        | 48  |                  | 38  |     | 38  |
| 107    | <b>tPCKATKB</b>  | CLK High to ATACKB Asserted<br>for Pending Access                                                               |     | 59      |        | 59  |                  | 47  |     | 47  |
| 108    | tPCKGH           | CLK High to GRANTB Asserted                                                                                     |     | 38      |        | 38  |                  | 30  |     | 30  |
| 109    | tPCKGL           | CLK High to GRANTB Negated                                                                                      |     | 32      |        | 32  |                  | 26  |     | 26  |
| 110    | tSADDCKG         | Row Address Setup to CLK High That<br>Asserts RAS following a GRANTB<br>Change to Ensure tASR = 0 ns for Port B | 11  |         | 15     |     | 11               |     | 16  |     |
| 111    | tSLOCKCK         | LOCK Asserted Setup to CLK Low to Lock Current Port                                                             | 5   |         | 5      |     | 5                |     | 5   |     |
| 112    | <b>tPAQATKBH</b> | AREQ Negated to ATACKB Negated                                                                                  |     | 26      |        | 26  |                  | 21  |     | 21  |
| 113    | tPAQBCASH        | AREQB Negated to CAS Negated                                                                                    |     | 59      |        | 67  |                  | 47  |     | 54  |
| 114    | tSADAQB          | Address Valid Setup to<br>AREQB Asserted                                                                        | 7   |         | 11     |     | 7                |     | 12  |     |
| 116    | tHCKARQG         | AREQ Negated Held from CLK High                                                                                 | 3   |         | 3      |     | 3                |     | 3   |     |
| 117    | tWAQB            | $\overline{\text{AREQB}}$ High Pulse Width to Guarantee tASR = 0 ns                                             | 31  |         | 35     |     | 26               |     | 31  |     |
| 118a   | tPAQBCAS0        | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)           |     | 95      |        | 103 |                  | 81  |     | 88  |
| 118b   | tPAQBCAS1        | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)          |     | 105     |        | 113 |                  | 91  |     | 98  |
| 118c   | tPAQBCAS2        | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)           |     | 105     |        | 113 |                  | 91  |     | 98  |
| 118d   | tPAQBCAS3        | $\overline{\text{AREQB}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)          |     | 115     |        | 123 |                  | 101 |     | 108 |
| 120a   | tPCKCASG0        | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 15 ns, tASC = 0 ns)               |     | 101     |        | 109 |                  | 86  |     | 93  |
| 120b   | tPCKCASG1        | CLK High to $\overrightarrow{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 15 ns, tASC = 0 ns)         |     | 111     |        | 119 |                  | 96  |     | 103 |
| 120c   | tPCKCASG2        | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 25 ns, tASC = 0 ns)               |     | 111     |        | 119 |                  | 96  |     | 103 |
| 120d   | tPCKCASG3        | CLK High to $\overline{CAS}$ Asserted<br>for Pending Port B Access<br>(tRAH = 25 ns, tASC = 10 ns)              |     | 121     |        | 129 |                  | 106 |     | 113 |
| 121    | tSBADDCKG        | Bank Address Valid Setup to CLK<br>High That Starts RAS<br>for Pending Port B Access                            | 10  |         | 10     |     | 10               |     | 10  |     |

Two different loads are specified:

DP8520A/DP8521A/DP8522A

## **15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A** (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$ , 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 VRAMs

per bank, including trace capacitance (see Note 2).

Two different loads are specified:

- $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0-3 and CAS0-3 and  $C_H=380$  pF loads on Q0-8, 9 and 10.

|        |                |                                                                                                 |     | 520A/21 | A/22A-         | 20  | 8520A/21A/22A-25 |     |     |     |
|--------|----------------|-------------------------------------------------------------------------------------------------|-----|---------|----------------|-----|------------------|-----|-----|-----|
| Number | Symbol         | Refresh Parameter<br>Description                                                                | CL  |         | C <sub>H</sub> |     | CL               |     | C   | н   |
|        |                | Description                                                                                     | Min | Max     | Min            | Max | Min              | Max | Min | Max |
| 200    | tSRFCK         | RFSH Asserted Setup to CLK High                                                                 | 17  |         | 17             |     | 15               |     | 15  |     |
| 201    | tSDRFCK        | DISRFSH Asserted Setup to CLK High                                                              | 18  |         | 18             |     | 15               |     | 15  |     |
| 202    | tSXRFCK        | EXTENDRF Setup to CLK High                                                                      | 15  |         | 15             |     | 12               |     | 12  |     |
| 204    | tPCKRFL        | CLK High to RFIP Asserted                                                                       |     | 42      |                | 42  |                  | 34  |     | 34  |
| 205    | tPARQRF        | AREQ Negated to RFIP Asserted                                                                   |     | 62      |                | 62  |                  | 50  |     | 50  |
| 206    | tPCKRFH        | CLK High to RFIP Negated                                                                        |     | 65      |                | 65  |                  | 51  |     | 51  |
| 207    | tPCKRFRASH     | CLK High to Refresh RAS Negated                                                                 |     | 35      |                | 40  |                  | 29  |     | 33  |
| 208    | tPCKRFRASL     | CLK High to Refresh RAS Asserted                                                                |     | 28      |                | 33  |                  | 23  |     | 27  |
| 209a   | tPCKCL0        | CLK High to CAS Asserted<br>during Error Scrubbing<br>(tRAH = 15 ns, tASC = 0 ns)               |     | 82      |                | 90  |                  | 73  |     | 80  |
| 209b   | tPCKCL1        | CLK High to $\overline{CAS}$ Asserted<br>during Error Scrubbing<br>(tRAH = 15 ns, tASC = 10 ns) |     | 92      |                | 100 |                  | 83  |     | 90  |
| 209c   | tPCKCL2        | CLK High to $\overline{CAS}$ Asserted<br>during Error Scrubbing<br>(tRAH = 25 ns, tASC = 0 ns)  |     | 92      |                | 100 |                  | 83  |     | 90  |
| 209d   | tPCKCL3        | CLK High to $\overline{CAS}$ Asserted<br>during Error Scrubbing<br>(tRAH = 25 ns, tASC = 10 ns) |     | 102     |                | 110 |                  | 93  |     | 100 |
| 210    | tWRFSH         | RFSH Pulse Width                                                                                | 15  |         | 15             |     | 15               |     | 15  |     |
| 211    | tPCKRQL        | CLK High to RFRQ Asserted                                                                       |     | 46      |                | 46  |                  | 40  |     | 40  |
| 212    | <b>tPCKRQH</b> | CLK High to RFRQ Negated                                                                        |     | 50      |                | 50  |                  | 40  |     | 40  |

# DP8520A/DP8521A/DP8522A

**15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 VRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

1000

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on  $\overline{RAS0-3}$  and  $\overline{CAS0-3}$  and  $C_H=380$  pF loads on Q0–8, 9 and 10.

|        |           |                                                                                                                                     | 8   | 520A/21                       | A/22A- | 20  | 8520A/21A/22A-25 |     |     |     |
|--------|-----------|-------------------------------------------------------------------------------------------------------------------------------------|-----|-------------------------------|--------|-----|------------------|-----|-----|-----|
| Number | Symbol    | Mode 0 Access<br>Parameter Description                                                                                              |     | C <sub>L</sub> C <sub>H</sub> |        |     |                  | CL  | C   | ѓн  |
|        |           | r arameter bescription                                                                                                              | Min | Max                           | Min    | Max | Min              | Max | Min | Max |
| 300    | tSCSCK    | CS Asserted to CLK High                                                                                                             | 14  |                               | 14     |     | 13               |     | 13  |     |
| 301a   | tSALECKNL | ALE Asserted Setup to CLK High<br>Not Using On-Chip Latches or<br>if Using On-Chip Latches and<br>B0, B1, Are Constant, Only 1 Bank | 16  |                               | 16     |     | 15               |     | 15  |     |
| 301b   | tSALECKL  | ALE Asserted Setup to CLK High,<br>if Using On-Chip Latches if B0, B1<br>Can Change, More Than One Bank                             | 29  |                               | 29     |     | 29               |     | 29  |     |
| 302    | tWALE     | ALE Pulse Width                                                                                                                     | 18  |                               | 18     |     | 13               |     | 13  |     |
| 303    | tSBADDCK  | Bank Address Valid Setup to CLK High                                                                                                | 20  |                               | 20     |     | 18               |     | 18  |     |
| 304    | tSADDCK   | Row, Column Valid Setup to<br>CLK High to Guarantee<br>tASR = 0 ns                                                                  | 11  |                               | 15     |     | 11               |     | 16  |     |
| 305    | tHASRCB   | Row, Column, Bank Address<br>Held from ALE Negated<br>(Using On-Chip Latches)                                                       | 10  |                               | 10     |     | 8                |     | 8   |     |
| 306    | tSRCBAS   | Row, Column, Bank Address<br>Setup to ALE Negated<br>(Using On-Chip Latches)                                                        | 3   |                               | 3      |     | 2                |     | 2   |     |
| 307    | tPCKRL    | CLK High to RAS Asserted                                                                                                            |     | 27                            |        | 32  |                  | 22  |     | 26  |
| 308a   | tPCKCL0   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)                                                                |     | 81                            |        | 89  |                  | 72  |     | 79  |
| 308b   | tPCKCL1   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)                                                               |     | 91                            |        | 99  |                  | 82  |     | 89  |
| 308c   | tPCKCL2   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 0 ns)                                                                |     | 91                            |        | 99  |                  | 82  |     | 89  |
| 308d   | tPCKCL3   | CLK High to $\overline{CAS}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)                                                               |     | 101                           |        | 109 |                  | 92  |     | 99  |
| 309    | tHCKALE   | ALE Negated Hold from CLK High                                                                                                      | 0   |                               | 0      |     | 0                |     | 0   |     |
| 310    | tSWINCK   | WIN Asserted Setup to CLK High to Guarantee CAS is Delayed                                                                          | -5  |                               | -5     |     | -5               |     | -5  |     |
| 311    | tPCSWL    | CS Asserted to WAIT Asserted                                                                                                        |     | 26                            |        | 26  |                  | 22  |     | 22  |
| 312    | tPCSWH    | CS Negated to WAIT Negated                                                                                                          |     | 26                            |        | 26  |                  | 22  |     | 22  |
| 313    | tPCLKDL1  | CLK High to DTACK Asserted (Programmed as DTACK0)                                                                                   |     | 41                            |        | 41  |                  | 33  |     | 33  |
| 314    | tPALEWL   | ALE Asserted to WAIT Asserted (CS is Already Asserted)                                                                              |     | 48                            |        | 48  |                  | 39  |     | 39  |
| 315    |           | AREQ Negated to CLK High That Starts<br>Access RAS to Guarantee tASR = 0 ns<br>(Non-Interleaved Mode Only)                          | 41  |                               | 45     |     | 34               |     | 39  |     |



**15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 VRAMs per bank, including trace capacitance (see Note 2).

 $C_L = 50 \text{ pF}$  loads on all outputs except  $C_L = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

- $C_H=50$  pF loads on all outputs except  $C_H=125$  pF loads on RAS0-3 and CAS0-3 and  $C_H=380$  pF loads on Q0-8, 9 and 10.

|        |          | Mode 1 Access                                                                                         | 85  | 20A/21 | A/22A- | ·20 | 8520A/21A/22A-25 |     |     |     |
|--------|----------|-------------------------------------------------------------------------------------------------------|-----|--------|--------|-----|------------------|-----|-----|-----|
| Number | Symbol   | Parameter Description                                                                                 | C   | L      | С      | Н   | C                | L   | С   | н   |
|        |          | •                                                                                                     | Min | Max    | Min    | Max | Min              | Max | Min | Max |
| 400a   | tSADSCK1 | ADS Asserted Setup to CLK High                                                                        | 8   |        | 8      |     | 7                |     | · 7 |     |
| 400b   | tSADSCKW | ADS Asserted Setup to CLK<br>(to Guarantee Correct WAIT<br>or DTACK Output; Doesn't Apply for DTACK0) | 31  |        | 31     |     | 25               |     | 25  |     |
| 401    | tSCSADS  | CS Setup to ADS Asserted                                                                              | 6   |        | 6      |     | 5                |     | 5   |     |
| 402    | tPADSRL  | ADS Asserted to RAS Asserted                                                                          |     | 30     |        | 35  |                  | 25  |     | 29  |
| 403a   | tPADSCL0 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 0 ns)   |     | 86     |        | 94  |                  | 75  |     | 82  |
| 403b   | tPADSCL1 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 15 ns, tASC = 10 ns)  |     | 96     |        | 104 |                  | 85  |     | 92  |
| 403c   | tPADSCL2 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)  |     | 96     |        | 104 |                  | 85  |     | 92  |
| 403d   | tPADSCL3 | $\overline{\text{ADS}}$ Asserted to $\overline{\text{CAS}}$ Asserted<br>(tRAH = 25 ns, tASC = 10 ns)  |     | 106    |        | 114 |                  | 95  |     | 102 |
| 404    | tSADDADS | Row Address Valid Setup to $\overline{\text{ADS}}$<br>Asserted to Guarantee tASR = 0 ns               | 9   |        | 13     |     | 9                |     | 14  |     |
| 405    | tHCKADS  | ADS Negated Held from CLK High                                                                        | 0   |        | 0      |     | 0                |     | 0   |     |
| 406    | tSWADS   | WAITIN Asserted Setup to ADS<br>Asserted to Guarantee DTACK0<br>Is Delayed                            |     |        | 0      |     | 0                |     | 0   |     |
| 407    | tSBADAS  | Bank Address Setup to ADS Asserted                                                                    | 11  |        | 11     |     | 11               |     | 11  |     |
| 408    | tHASRCB  | Row, Column, Bank Address Held from<br>ADS Asserted (Using On-Chip Latches)                           | 10  |        | 10     |     | 8                |     | 8   |     |
| 409    | tSRCBAS  | Row, Column, Bank Address Setup to<br>ADS Asserted (Using On-Chip Latches)                            | 3   |        | 3      |     | 2                |     | 2   |     |
| 410    | tWADSH   | ADS Negated Pulse Width                                                                               | 12  |        | 16     |     | 12               |     | 17  |     |
| 411    | tPADSD   | ADS Asserted to DTACK Asserted<br>(Programmed as DTACK0)                                              |     | 43     |        | 43  |                  | 35  |     | 35  |
| 412    | tSWINADS | WIN Asserted Setup to ADS Asserted<br>(to Guarantee CAS Delayed during<br>Writes Accesses)            | -10 |        | -10    |     | 10               |     | -10 |     |
| 413    | tPADSWL0 | ADS Asserted to WAIT Asserted<br>(Programmed as WAIT0, Delayed Access)                                |     | 46     |        | 46  |                  | 37  |     | 37  |
| 414    | tPADSWL1 | ADS Asserted to WAIT Asserted<br>(Programmed WAIT 1/2 or 1)                                           |     | 38     |        | 38  |                  | 31  |     | 31  |
| 415    | tPCLKDL1 | CLK High to DTACK Asserted<br>(Programmed as DTACK0,<br>Delayed Access)                               |     | 41     |        | 41  |                  | 33  |     | 33  |
| 416    |          | AREQ Negated to ADS Asserted<br>to Guarantee tASR = 0 ns<br>(Non Interleaved Mode Only)               | 38  |        | 42     |     | 31               |     | 36  |     |

## **15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A** (Continued) Unless otherwise stated $V_{CC} = 5.0V \pm 10\%$ , 0°C < $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 VRAMs

per bank, including trace capacitance (see Note 2).

 $C_L = 50 \text{ pF}$  loads on all outputs except

- $C_H=50~pF$  loads on all outputs except  $C_H=125~pF$  loads on RAS0–3 and CAS0–3 and  $C_H=380~pF$  loads on Q0–8, 9 and 10.

 $C_{L} = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

|        |           |                                                                                                                        | 8520A/21A/22A-20 |     |     |                | 8520A/21A/22A-25 |     |     |     |
|--------|-----------|------------------------------------------------------------------------------------------------------------------------|------------------|-----|-----|----------------|------------------|-----|-----|-----|
| Number | Symbol    | Mode 1 Dual Access Parameter Description                                                                               |                  | CL  |     | C <sub>H</sub> |                  | CL  |     | н   |
|        |           |                                                                                                                        | Min              | Max | Min | Max            | Min              | Max | Min | Max |
| 450    | tSADDCKG  | Row Address Setup to CLK High That<br>Asserts $\overline{RAS}$ following a GRANTB<br>Port Change to Ensure tASR = 0 ns | 11               |     | 15  |                | 11               |     | 16  |     |
| 451    | tPCKRASG  | CLK High to RAS Asserted<br>for Pending Access                                                                         |                  | 48  |     | 53             |                  | 38  |     | 42  |
| 452    | tPCLKDL2  | CLK to DTACK Asserted for Delayed<br>Accesses (Programmed as DTACK0)                                                   |                  | 53  |     | 53             |                  | 43  |     | 43  |
| 453a   | tPCKCASG0 | CLK High to $\overline{CAS}$ Asserted<br>for Pending Access<br>(tRAH = 15 ns, tASC = 0 ns)                             |                  | 101 |     | 109            |                  | 86  |     | 93  |
| 453b   | tPCKCASG1 | CLK High to <del>CAS</del> Asserted<br>for Pending Access<br>(tRAH = 15 ns, tASC = 10 ns)                              |                  | 111 |     | 119            |                  | 96  |     | 103 |
| 453c   | tPCKCASG2 | CLK High to $\overline{CAS}$ Asserted<br>for Pending Access<br>(tRAH = 25 ns, tASC = 0 ns)                             |                  | 111 |     | 119            |                  | 96  |     | 103 |
| 453d   | tPCKCASG3 | CLK High to $\overline{CAS}$ Asserted<br>for Pending Access<br>(tRAH = 25 ns, tASC = 10 ns)                            |                  | 121 |     | 129            |                  | 106 |     | 113 |
| 454    | tSBADDCKG | Bank Address Valid Setp to CLK High That Asserts $\overline{\text{RAS}}$ for Pending Access                            | 5                |     | 5   |                | 4                |     | 4   |     |
| 455    | tSADSCK0  | ADS Asserted Setup to CLK High                                                                                         | 12               |     | 12  |                | 11               |     | 11  |     |

**15.0 AC Timing Parameters: DP8520A/DP8521A/DP8522A** (Continued) Unless otherwise stated  $V_{CC} = 5.0V \pm 10\%$ , 0°C <  $T_A < 70$ °C, the output load capacitance is typical for 4 banks of 18 VRAMs per bank, including trace capacitance (see Note 2).

Two different loads are specified:

 $C_L = 50 \text{ pF}$  loads on all outputs except

 $C_{I} = 150 \text{ pF}$  loads on Q0-8, 9 and 10; or

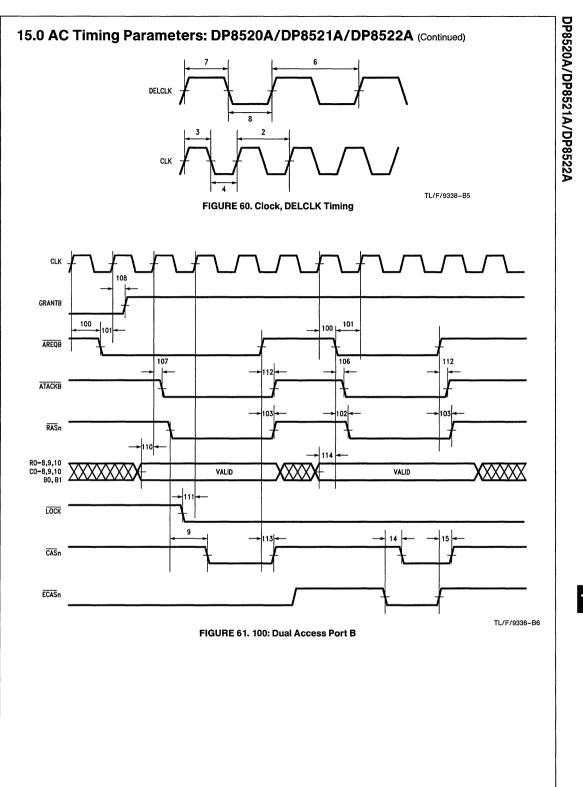
 $C_H = 50 \text{ pF}$  loads on all outputs except

 $C_{\rm H}$  = 125 pF loads on RAS0-3 and CAS0-3 and  $C_{\rm H}$  = 380 pF loads on Q0-8, 9 and 10.

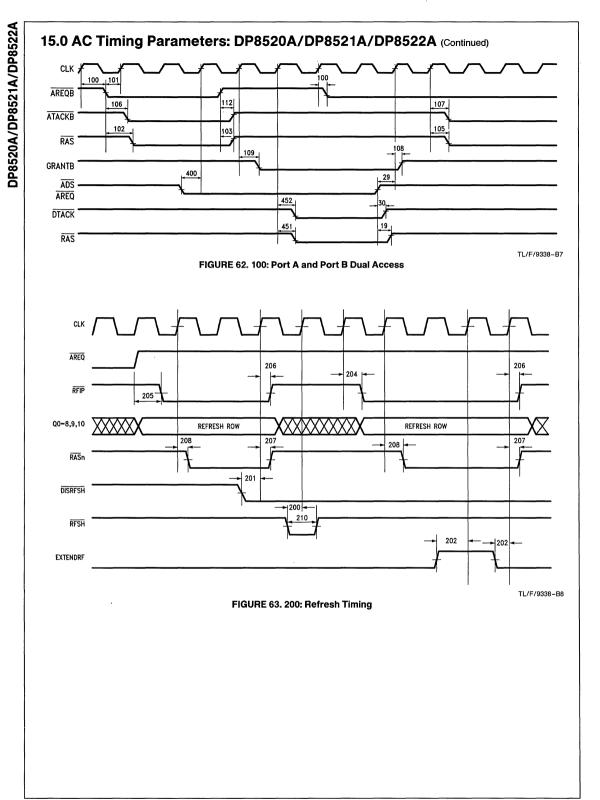
|        |           |                                                                                                                                                                                                                         | 85  | 520A/21 | A/22A- | 20  | 85  | 520A/21 | A/22A- | 25  |
|--------|-----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|---------|--------|-----|-----|---------|--------|-----|
| Number | Symbol    | Programming<br>Parameter Description                                                                                                                                                                                    |     | CL      |        | н   | CL  |         | C      | н   |
|        |           | Parameter Description                                                                                                                                                                                                   | Min | Max     | Min    | Max | Min | Max     | Min    | Max |
| 500    | tHMLADD   | Mode Address Held from ML Negated                                                                                                                                                                                       | 6   |         | 6      |     | 5   |         | 5      |     |
| 501    | tSADDML   | Mode Address Setup to ML Negated                                                                                                                                                                                        | 6   |         | 6      |     | 6   |         | 6      |     |
| 502    | tWML      | ML Pulse Width                                                                                                                                                                                                          | 15  |         | 15     |     | 15  |         | 15     |     |
| 503    | tSADAQML  | Mode Address Setup to AREQ Asserted                                                                                                                                                                                     | 0   |         | 0      |     | 0   |         | 0      |     |
| 504    | tHADAQML  | Mode Address Held from AREQ Asserted                                                                                                                                                                                    | 39  |         | 39     |     | 29  |         | 29     |     |
| 505    | tSCSARQ   | CS Asserted Setup to<br>AREQ Asserted                                                                                                                                                                                   | 6   |         | 6      |     | 6   |         | 6      |     |
| 506    | tSMLARQ   | ML Asserted Setup to AREQ Asserted                                                                                                                                                                                      | 10  |         | 10     |     | 10  |         | 10     |     |
| 600    | tSCKVSRL  | $\label{eq:VSRL} \begin{array}{ c c }\hline \hline VSRL & Low Setup to CLK Rising Edge to \\guarantee counting \overline{VSRL} as being Low \\(used to determine when to end Graphics \\Shift load access) \end{array}$ | 8   |         | 8      |     | 7   |         | 7      |     |
| 601    | tHVSRLCK  | VSRL Low from CLK High (to guarantee<br>VSRL is not counted as being Low until<br>the next rising clock edge)                                                                                                           | 4   |         | 4      |     | 3   |         | 3      |     |
| 602    | tSCKAVSRL | AVSRLRQ Low before CLK Rising Edge<br>to guarantee locking the VRAM to only<br>Port A accesses                                                                                                                          | 13  |         | 13     |     | 12  |         | 12     |     |
| 603    | tPVSRLDTL | VSRL Low to DT/OE Low during<br>Graphics Shift Register Load access                                                                                                                                                     |     | 25      |        | 35  |     | 23      |        | 33  |
| 604    | tPVSRLDTH | VSRL Negated to DT/OE Negated                                                                                                                                                                                           |     | 24      |        | 34  |     | 22      |        | 32  |
| 605    | tPCKDTL   | CLK to DT/OE Negated                                                                                                                                                                                                    |     | 30      |        | 40  |     | 27      |        | 37  |

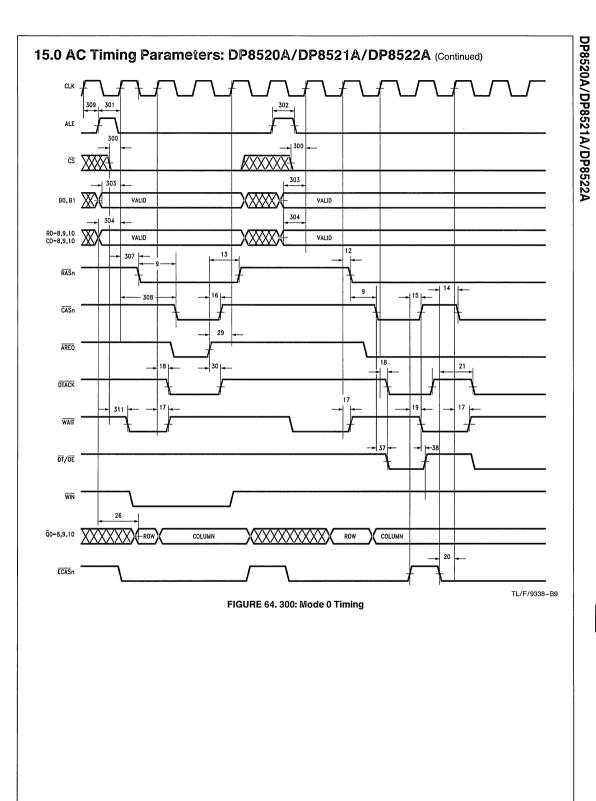
Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

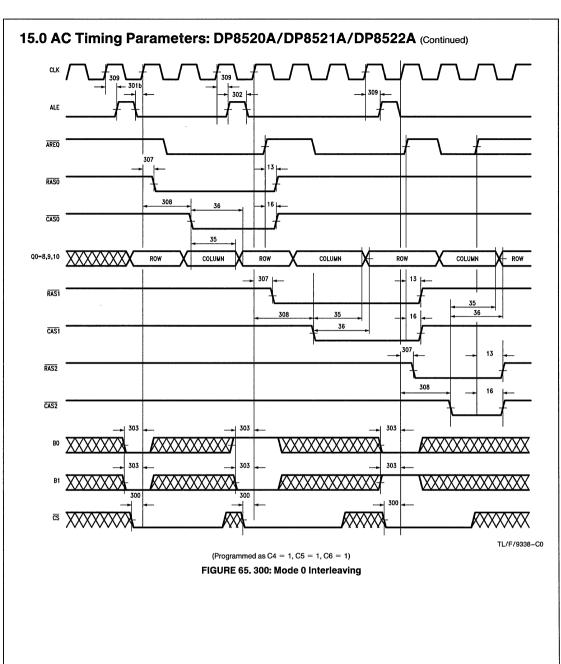
Note 2: Input pulse 0V to 3V; tR = tF = 2.5 ns. Input reference point on AC measurements is 1.5V. Output reference points are 2.4V for High and 0.8V for Low. Note 3: AC Production testing is done at 50 pF.

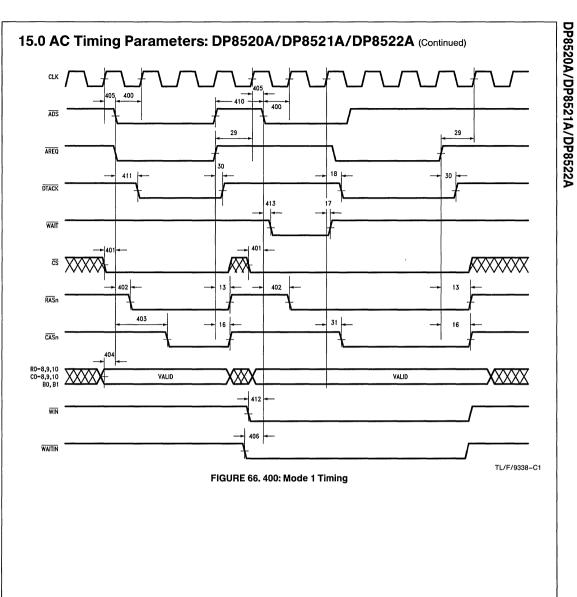


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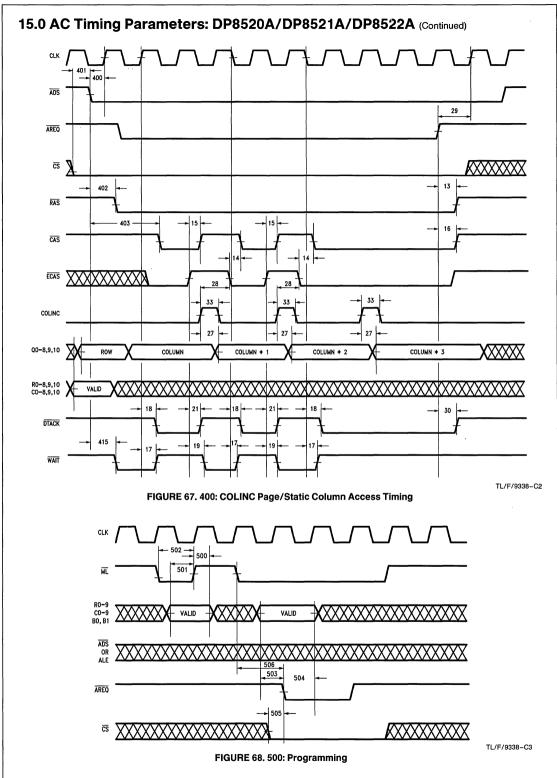




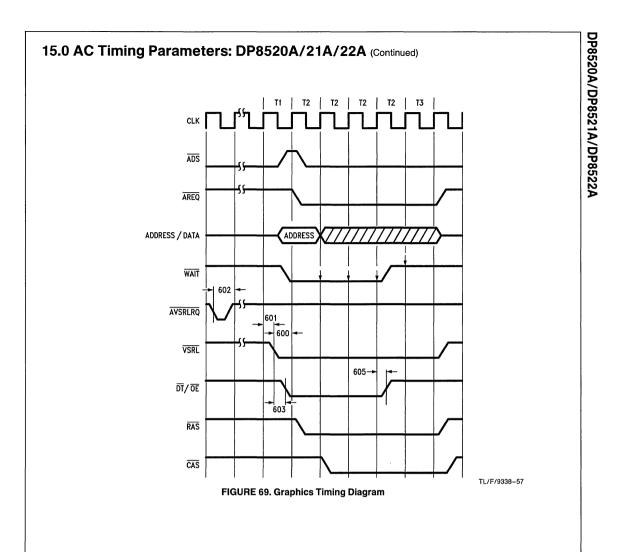




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# DP8520A/DP8521A/DP8522A



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### 16.0 Functional Differences between the DP8520A/21A/22A and the DP8520/21/22

### 1. Extending the Column Address Strobe (CAS)

 $\label{eq:cases} \begin{array}{l} \hline CAS \mbox{ can be extended indefinitely after $\overline{AREQ}$ transitions high in non-interleaved mode only, providing that the user program the DP8520A/21A/22A with the ECAS0 (negated) during programming. To extend $\overline{CAS}$, the user continues to assert any or multiple $\overline{ECASs}$ after negating $\overline{AREQ}$. Extending $\overline{CAS}$ with $\overline{RAS}$ negated can be used to gain $\overline{RAS}$ precharge time. By negating $\overline{AREQ}$, $\overline{RAS}$ will be negated. The user can then continue to assert a one or both of the $\overline{ECASs}$, which will keep $\overline{CAS}$ asserted with $\overline{RAS}$ negated. By keeping $\overline{CAS}$ asserted with $\overline{RAS}$ negated. Even though $\overline{CAS}$ will be extended, $\overline{DTACK}$ output will always end from $\overline{AREQ}$ negated.$ 

### 2. Extending DT/OE Functionality

The  $\overline{\text{DT}}/\overline{\text{OE}}$  output will follow the  $\overline{\text{CAS}}$  output during a VRAM read access, and will remain negated during a VRAM write access. For the DP8520/21/22, the  $\overline{\text{DT}}/\overline{\text{OE}}$  output remained negated for all VRAM access cycles. This will allow the VRAM to drive the data bus. There are 2 options for the function of the  $\overline{\text{DT}}/\overline{\text{OE}}$  output during a video shift register load operation. With ECASO negated during programming, the  $\overline{\text{DT}}/\overline{\text{OE}}$  output will follow the  $\overline{\text{VSRL}}$  input during video shift register load operations. With the ECASO asserted during programming, VSRL will assert  $\overline{\text{DT}}/\overline{\text{OE}}$  to be negated. VSRL asserted more than four rising clock edges will cause  $\overline{\text{DT}}/\overline{\text{OE}}$  to be negated from the fourth rising clock edge.

### 3. Dual Accessing

RAS will be asserted either one or two clock periods after GRANTB has been asserted. The amount of RAS low and high time, programmed by bits R0 and R1, determines the number of clock periods after GRANTB changes before RAS will start. This is shown in the table below.

| R0, R1 | RAS<br>Precharge<br>Time | RAS Asserted<br>During<br>Refresh | RAS Asserted from GRANTB Change |
|--------|--------------------------|-----------------------------------|---------------------------------|
| 0, 0   | 1T                       | 2T                                | 1 Rising Clock Edge             |
| 0, 1   | 2T                       | 2T                                | 1 Rising Clock Edge             |
| 1,0    | 2T                       | 3T                                | 2 Rising Clock Edges            |
| 1, 1   | 3T                       | 4T                                | 2 Rising Clock Edges            |

### 4. Refresh Clock Counter

The refresh clock counter will count and assert  $\overline{\text{RFRQ}}$  externally when it is time to do a refresh. This will occur even when internal refreshes are disabled. This allows the user to run the chip in a request/acknowledge mode for refreshing. ECAS0 is used to program the  $\overline{\text{RFIP}}$  output to act as either refresh request ( $\overline{\text{RFRQ}}$ ) or  $\overline{\text{RFIP}}$ . ECAS0 asserted during programming causes the  $\overline{\text{RFIP}}$  output to function as  $\overline{\text{RFIP}}$ . ECAS0 negated during programming causes the  $\overline{\text{RFIP}}$  output to function as  $\overline{\text{RFIP}}$ .

### 5. Clearing the Refresh Clock

The refresh clock counter is cleared by negating DISRFSH and asserting RFSH for at least 500 ns.

### 17.0 DP8520A/21A/22A User Hints

1. All inputs to the DP8520A/21A/22A should be tied high, low or the output of some other device.

Note: One signal is active high. COLINC (EXTNDRF) should be tied low to disable.

- 2. Each ground on the DP8520A/21A/22A must be decoupled to the closest on-chip supply (V<sub>CC</sub>) with 0.1  $\mu$ F ceramic capacitor. This is necessary because these grounds are kept separate inside the DP8520A/21A/22A. The decoupling capacitors should be placed as close as possible with short leads to the ground and supply pins of the DP8520A/21A/22A.
- 3. The output called "CAP" should have a 0.1  $\mu\text{F}$  capacitor to ground.
- 4. The DP8520A/21A/22A has  $20\Omega$  series damping resistors built into the output drivers of RAS, CAS, address and DT/OE. Space should be provided for external damping resistors on the printed circuit board (or wirewrap board) because they may be needed. The value of these damping resistors (if needed) will vary depending upon the output, the capacitance of the load, and the characteristics of the trace as well as the routing of the trace. The value of the damping resistor also may vary between the wire-wrap board and the printed circuit board. To determine the value of the series damping resistor it is recommended to use an oscilloscope and look at the furthest VRAM from the DP8520A/21A/22A. The undershoot of RAS, CAS, DT/OE and the addresses should be kept to less than 0.5V below ground by varying the value of the damping resistor. The damping resistors should be placed as close as possible with short leads to the driver outputs of the DP8520A/21A/22A.
- 5. The circuit board must have a good V<sub>CC</sub> and ground plane connection. If the board is wire-wrapped, the V<sub>CC</sub> and ground pins of the DP8520A/21A/22A, the VRAM associated logic and buffer circuitry must be soldered to the V<sub>CC</sub> and ground planes.
- 6. The traces from the DP8520A/21A/22A to the VRAM should be as short as possible.
- ECAS0 should be held low during programming if the user wishes that the DP8520A/21A/22A be compatible with a DP8520/21/22 design.

### 18.0 Description of a DP8522A/ DP8500 System Interface

Several simple block and timing diagrams are inserted to help the user design a system interface between the DP8520A/21A/22A VRAM controller and the Raster Graphics Processor DP8500 (as shown in *Figure 70*). For accessing the VRAM, the DP8520A/21A/22A uses the RGP's PHI 2 clock as an input clock and it runs in Mode 1 (asynchronous mode). This allows the user to guarantee row, column and bank address set up times to a rising clock edge (as shown in timing calculations provided). This system design uses a PAL® to interface the access request logic and the wait logic between the DP8522A and the RGP. External logic is also needed for plane control.

### 18.0 Description of a DP8522A/DP8500 System Interface (Continued)

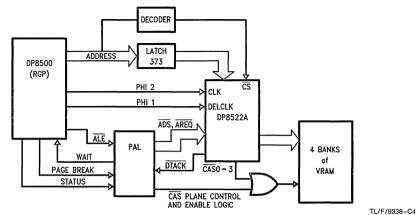


FIGURE 70. DP8422A/DP8500 (RGP) Interface Block Diagram

The main idea of the block diagram in *Figure 73* is to cause the video DRAM shift register load operation to happen correctly. Once the DP8500 (RGP) issues the Display Refresh REQuest signal (DRREQ) the system knows that the video shift register load operation should occur at a certain defined time later. In the block diagram this time is controlled by the counter device. This counter determines when VSRL transitions high, thereby causing the video shift register load operation.

In the upper part of the block diagram is the "REFRESH" output that is used as the "VSRL" input of the DP8522A and is also used to create "REFRESH NOT DONE". To creat the "REFRESH" output a NAND latch is used. This latch is set when a screen refresh is in progress, shown by the RGP outputs ALE, B0, and B1 all being high. If the status of the RGP is anything other than screen refresh the latch is reset. The latch is also reset during a screen refresh when the load shift register counter times out. This counter determines when the "VSRL" input of the DP8522A transitions high, causing the video DRAMs to load a row of data into their shift registers.

The "REFRESH" signal along with the load shift register counter output "NOT DONE" are used to create the "REFRESH NOT DONE" signal. This output is used for two purposes. One of which is to hold the "WAIT" output low, thereby inserting WAIT states into the RGP video shift register load access. The other purpose is to hold "DT/OE" low until "VSRL" transitions high.

Important setup timing parameters which must be met for a DP8500(RGP)–DP8522A system (assuming RGP is running at 20 MHz ( $T_{CP} = 50$  ns)).

### 1. Address Setup to ADS Asserted

= 1 T\_{CP} -  $\#t_{ALV}$  + Derating the DP8500 Spec for Light Load -  $t_{PF373}$  + Min PAL Delay to Produce ADS & AREQ

- = 50 ns 38 ns + 5 ns 8 ns + 2 ns
- = 11 ns

(Using Light Load Timing Specs, the DP8520A/21A/22A Needs)

- 9 ns Setup for Row Address to ADS Asserted
- 11 ns Setup for Bank Address to ADS Asserted

### 2. ADS Setup to Clock Rising Edge

- = 1 T<sub>CP</sub> #t<sub>ALEV</sub> Max PAL Delay
- = 50 ns 26 ns 10 ns
- = 14 ns

(DP8520A/21A/22A Needs 7 ns)

- 3. WAIT Negated Setup to Clock
  - = 1 T<sub>CP</sub> \$18 Max PAL Delay
  - = 50 ns 28 ns 10 ns
  - = 12 ns

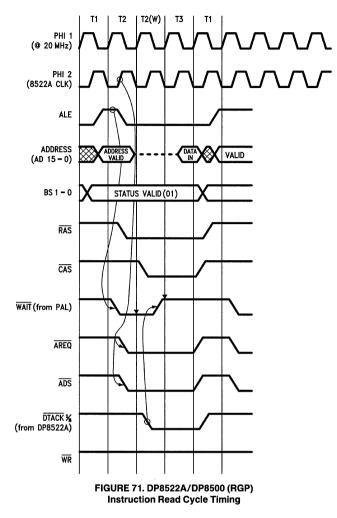
(The DP8500 Needs 5 ns Setup Time)

Note 1: "\$" symbol refers to a DP8520A/21A/22A timing parameter.

Note 2: "#" symbol refers to a DP8500 timing parameter.

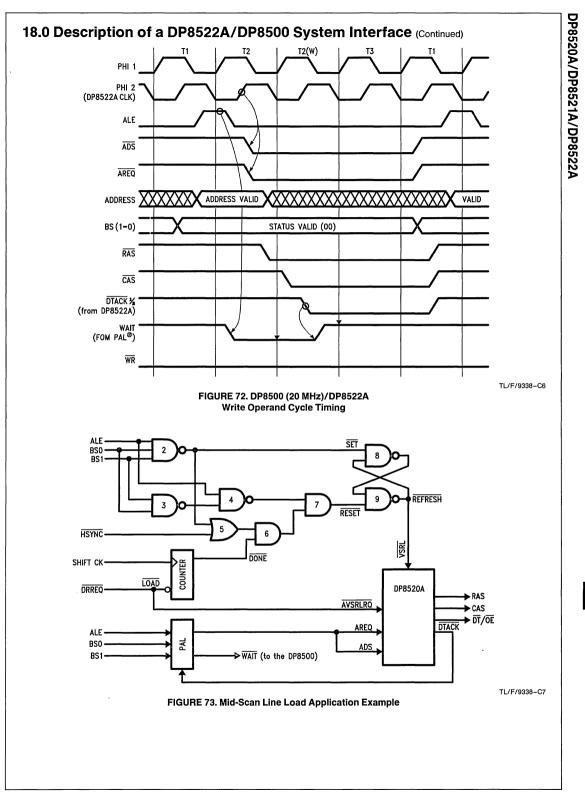
Note 3: ALE asserted by the RGP (DP8500) should use the system PAL to assert WAIT in order to guarantee proper setup time.  $\overline{\text{DTACK}}$  low should then be used to negate the WAIT signal through PAL equations.

### 18.0 Description of a DP8522A/DP8500 System Interface (Continued)

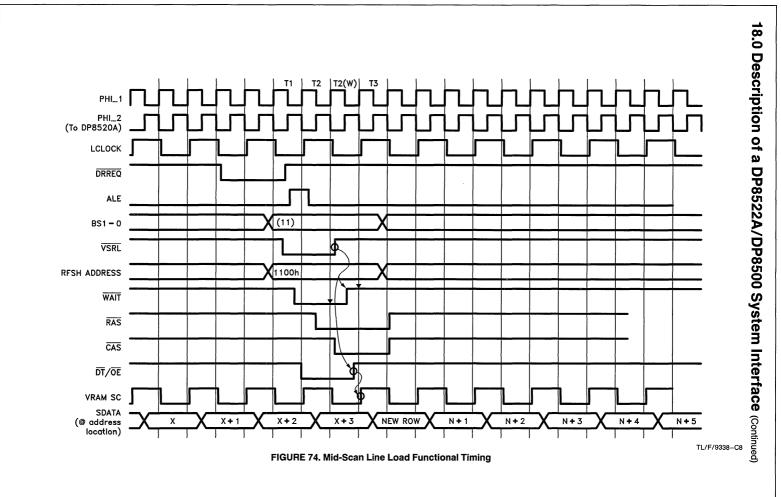


TL/F/9338-C5

DP8520A/DP8521A/DP8522A



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### 29F68 256 Kbit Dynamic RAM Controller

### **General Description**

Logic Symbol

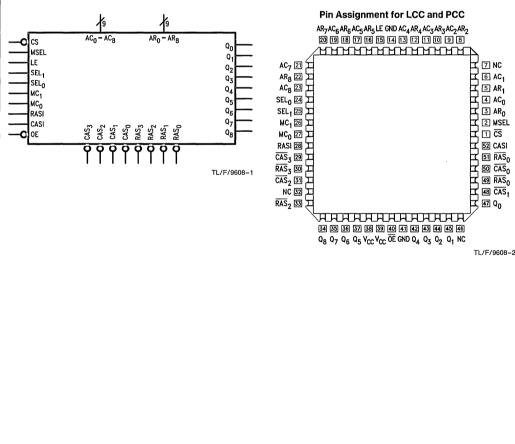
The 29F68 is a high-performance memory controller, replacing many SSI and MSI devices by grouping several unique functions. It provides two 9-bit address latches and two 9-bit counters for row and column address generation during refresh. A 2-bit bank select latch for row and column address generation during refresh, and a 2-bit bank select latch for the two high order address bits are provided to select one of the four RAS and CAS outputs.

The 29F68 is functionally equivalent to AMD's Am2968 and Motorola's MC74F2968.

### Features

- □ High-performance memory controller
- Replaces many SSI and MSI devices by grouping several unique functions
- □ Functionally equivalent to AMD's Am2968 and Motorola's MC74F2968
- Provides control for 16K, 64K, or 256K dynamic RAM systems
- Outputs directly drive up to 88 DRAMs
- Highest order two address bits select one of four banks of RAMs
- □ Chip Select for easy expansion
- D Provides memory refresh with error correction mode

### **Connection Diagram**



29F68

| Name                                                                 | 1/0 | Description                                                                                                                                                                                                                                                                                                                                                                                                                               |
|----------------------------------------------------------------------|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AR <sub>0</sub> -AR <sub>8</sub><br>AC <sub>0</sub> -AC <sub>8</sub> | I   | Address Inputs. AR <sub>0</sub> –AR <sub>8</sub> are latched in as the 9-bit Row Address for the RAM. These inputs drive $Q_0-Q_8$ when the 29F68 is in the Read/Write mode and MSEL is LOW. AC <sub>0</sub> –AC <sub>8</sub> are latched in as the Column Address, and will drive $Q_0-Q_8$ when MSEL is HIGH and the 29F68 is ir the Read/Write mode. The addresses are latched with the Latch Enable (LE) signal.                      |
| SEL <sub>0</sub> -SEL <sub>1</sub>                                   | Ι   | <b>Bank Select</b> . These two inputs are normally the two higher order address bits, and are used in the Read/Write mode to select which bank of memory will be receiving the $\overline{RAS}_n$ and $\overline{CAS}_n$ signals after RASI and CASI go HIGH.                                                                                                                                                                             |
| LE                                                                   | I   | Latch Enable. This active-HIGH input causes the Row, Column and<br>Bank Select latches to become transparent, allowing the latches to<br>accept new input data. A LOW input on LE latches the input data,<br>assuming it meets the setup and hold time requirements.                                                                                                                                                                      |
| MSEL                                                                 | I   | Multiplexer Select. This input determines whether the Row or Column<br>Address will be sent to the memory address inputs. When MSEL is<br>HIGH the Column Address is selected, while the Row Address is<br>selected when MSEL is LOW. The address may come from either the<br>address latch or refresh address counter depending on MC <sub>0</sub> , MC <sub>1</sub> .                                                                   |
| <u>cs</u>                                                            | Ι   | Chip Select. This active-LOW input is used to enable the 29F68. When CS is active, the 29F68 operates normally in all four modes. When CS goes HIGH, the device will not enter the Read/Write mode. This allows other devices to access the same memory that the 29F68 is controlling (e.g., DMA controller).                                                                                                                             |
| ŌĒ                                                                   | Ι   | <b>Output Enable.</b> This active-LOW input enables/disables the output signals. When $\overline{OE}$ is HIGH, the outputs of the 29F68 enter the high impedance state. The $\overline{OE}$ signal allows more than one 29F68 to controt the same memory, thus providing an easy method to expand the memory size.                                                                                                                        |
| МС <sub>0</sub> , МС <sub>1</sub>                                    | I   | <b>Mode Control.</b> These inputs are used to specify which of the four operating modes the 29F68 should be using. The description of the four operating modes is given in the Mode Control Function Table.                                                                                                                                                                                                                               |
| Q <sub>0</sub> -Q <sub>8</sub>                                       | 0   | Address Outputs. These address outputs will feed the DRAM addres<br>inputs and provide drive for memory systems up to 500 pF in<br>capacitance.                                                                                                                                                                                                                                                                                           |
| RASI                                                                 | I   | <b>Row Address Strobe Input.</b> During normal memory cycles, the decoded $RAS_n$ output ( $RAS_0$ , $RAS_1$ , $RAS_2$ or $RAS_3$ ) is forced LOW after receipt of RASI. In either refresh mode, all four $RAS_n$ outputs will go LOW following RASI going HIGH.                                                                                                                                                                          |
| RAS <sub>0</sub> -RAS <sub>3</sub>                                   | 0   | <b>Row Address Strobe</b> . Each one of the Row Address Strobe outputs provides a $\overline{RAS}_n$ signal to one of the four banks of dynamic memory. Each will go LOW only when selected by $SEL_0$ and $SEL_1$ and only after RASI goes HIGH. All four go LOW in response to RASI in either of the Refresh modes.                                                                                                                     |
| CASI                                                                 | I   | Column Address Strobe Input. This input going active will cause the selected $\overline{CAS}_n$ output to be forced LOW.                                                                                                                                                                                                                                                                                                                  |
| CAS <sub>0</sub> -CAS <sub>3</sub>                                   | 0   | Column Address Strobe. During normal Read/Write cycles the two select bits (SEL <sub>0</sub> , SEL <sub>1</sub> ) determine which $\overline{CAS}_n$ output will go active following CASI going HIGH. When memory error correction is performed, only the $\overline{CAS}_n$ signal selected by CNTR <sub>0</sub> and CNTR <sub>1</sub> will be active. For non-error correction cycles, all four $\overline{CAS}_n$ outputs remain HIGH. |

### **Functional Description**

The 29F68 is designed to be used with 16k, 64k, or 256k dynamic RAMs and is functionally equivalent to AMD's AM2968. The 29F68 provides row/column address multiplexing, refresh address generation and bank selection for up to four banks of RAMs.

Twenty (20) address bits ( $AR_0-AR_8$ ,  $AC_0-AC_8$ , and bank select addresses  $SEL_0$  and  $SEL_1$ ) are presented to the controller. These addresses are latched by a 20-bit latch. A 20-bit counter generates the refresh address.

A 9-bit multiplexer selects the output address between the input row address, column address, refresh counter row address, column address, or zero (clear). Four RAS and four CAS outputs select the appropriate bank of RAMs and strobe in the row and column addresses.

It should be noted that the counters are cleared (MC\_0, MC\_1 = 1,1) on the next RASI transition, but the Q outputs are asynchronously cleared through the multiplexer.

|                 | Mode Control Function Table |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |  |  |  |  |
|-----------------|-----------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|--|
| MC <sub>1</sub> | MCo                         | Operating Mode                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |  |  |  |  |  |  |
| 0               | 0                           | <b>Refresh without Error Correction.</b> Refresh cycles are performed with only the Row Counter being used to generate addresses. In this mode, all four $\overline{RAS}_n$ outputs are active while the four $\overline{CAS}_n$ signals are kept HIGH.                                                                                                                                                                                                                                                                                              |  |  |  |  |  |  |
| 0               | 1                           | <b>Refresh with Error Correction/Initialize</b> —During this mode, refresh cycles are done with both the Row and Column counters generating the addresses. MSEL is used to select between the Row and Column counter. All four RAS <sub>n</sub> outputs go active in response to RASI, while only one $\overline{CAS_n}$ output goes LOW in response to CASI. The Bank Counter keeps track of which $\overline{CAS_n}$ output will go active. This mode is also used on system power-up so that the memory can be written with a known data pattern. |  |  |  |  |  |  |
| 1               | 0                           | <b>Read/Write</b> — This mode is used to perform Read/Write cycles. Both the Row and Column addresses are latched and multiplexed to the address output lines using MSEL; SEL <sub>0</sub> and SEL <sub>1</sub> are decoded to determine which $\overrightarrow{RAS}_n$ and $\overrightarrow{CAS}_n$ will be active.                                                                                                                                                                                                                                 |  |  |  |  |  |  |
| 1               | 1                           | <b>Clear Refresh Counter</b> —This mode will clear the three refresh counters (Row, Column, and Bank) on the HIGH-to-LOW transition of RASI, putting them at the start of the refresh sequence. In this mode, all four $\overline{RAS}_n$ are driven LOW upon receipt of RASI so that DRAM wake-up cycles may be performed. This mode also asynchronously clears the $Q_n$ outputs.                                                                                                                                                                  |  |  |  |  |  |  |

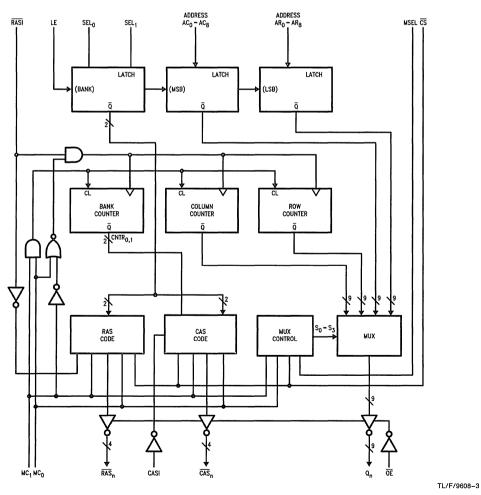
| Address Output Function Table |                 |                 |      |                                  |                        |  |  |  |  |
|-------------------------------|-----------------|-----------------|------|----------------------------------|------------------------|--|--|--|--|
| CS                            | MC <sub>1</sub> | MC <sub>0</sub> | MSEL | Mode                             | MUX Output             |  |  |  |  |
| L                             | L               | L               | х    | Refresh without Error Correction | Row Counter Address    |  |  |  |  |
|                               | L               | н               | н    | Refresh with Error Correction    | Column Counter Address |  |  |  |  |
|                               |                 |                 | L    |                                  | Row Counter Address    |  |  |  |  |
|                               | Н               | L               | Н    | Read/Write                       | Column Address Latch   |  |  |  |  |
|                               |                 |                 | L    |                                  | Row Address Latch      |  |  |  |  |
|                               | Н               | Н               | х    | Clear Refresh Counter            | Zero                   |  |  |  |  |
| н                             | L               | L               | Х    | Refresh without Error Correction | Row Counter Address    |  |  |  |  |
|                               | L               | н               | н    | Refresh with Error Correction    | Column Counter Address |  |  |  |  |
|                               |                 |                 | L    |                                  | Row Counter Address    |  |  |  |  |
|                               | Н               | L               | х    | Read/Write                       | Zero                   |  |  |  |  |
|                               | Н               | н               | х    | Clear Refresh Counter            | Zero                   |  |  |  |  |

| RASI | CS | MC <sub>1</sub> | MC <sub>0</sub> | SEL1  | SEL <sub>0</sub> |                   | Mode                                 |                  | RAS <sub>0</sub> | RAS <sub>1</sub> | RAS <sub>2</sub> | RAS |  |
|------|----|-----------------|-----------------|-------|------------------|-------------------|--------------------------------------|------------------|------------------|------------------|------------------|-----|--|
| L    | x  | х               | Х               | Х     | X                | Non-refres        | sh                                   |                  | н                | н                | н                | н   |  |
| н    | L  | L               | L               | х     | X                | Refresh w         | ithout Scru                          | bbing            | L                | L                | L                | L   |  |
|      |    | L               | Н               | Х     | X                | Refresh w         | Refresh with Scrubbing<br>Read/Write |                  | L                | L                | L                | L   |  |
|      |    | н               | L               | L     | L                | Read/Writ         |                                      |                  | L                | н                | н                | н   |  |
|      |    |                 |                 | L     | н                |                   |                                      |                  | н                | L                | н                | н   |  |
|      |    |                 |                 | Н     | L                | ]                 |                                      |                  | н                | н                | L                | н   |  |
|      |    |                 |                 | Н     | н                |                   |                                      |                  | н                | Н                | н                | L   |  |
|      |    | н               | н               | х     | X                | Clear Refr        | esh Counte                           | ər               | L                | L                | L                | L   |  |
|      | н  | L               | L               | х     | х                | Refresh w         | ithout Error                         | Correction       | L                | L                | L                | L   |  |
|      |    | L               | Н               |       |                  | Refresh w         | ith Error Co                         | prrection        | L                | L                | L                | L   |  |
|      | [  | н               | L               |       |                  | Read/Writ         | te                                   |                  | н                | н                | н                | F   |  |
|      |    | н               | Н               |       |                  | Clear Refr        | esh Counte                           | ər               | L                | L                | L                | L   |  |
|      |    |                 |                 |       | CA               | S Output Fu       | nction Tat                           | ble              |                  |                  |                  |     |  |
|      | In | puts            |                 |       | Internal C       | ounter            | Inp                                  | outs             |                  | Outputs          |                  |     |  |
| CASI | CS | MC <sub>1</sub> | MC              | CN    | TR <sub>1</sub>  | CNTR <sub>0</sub> | SEL1                                 | SEL <sub>0</sub> | CAS <sub>0</sub> |                  | CAS <sub>2</sub> | CAS |  |
| н    | L  | L               | L               | )     | ×                | х                 | x                                    | x                | н                | н                | н                | н   |  |
|      |    | L               | н               |       | L                | L                 | x                                    | x                | L                | н                | н                | н   |  |
|      |    |                 |                 |       | L                | Н                 |                                      |                  | н                | L                | н                | н   |  |
|      |    |                 |                 | H     | 4                | L                 |                                      |                  | н                | н                | L                | н   |  |
|      |    |                 |                 | H     | 4                | н                 |                                      |                  | н                | н                | н                | L   |  |
|      |    | н               | L               | 2     | ×                | х                 | L                                    | L                | Ł                | н                | н                | Н   |  |
|      |    |                 |                 |       |                  |                   | L                                    | н                | н                | L                | н                | Н   |  |
|      |    |                 |                 |       |                  |                   | н                                    | L                | н                | н                | L                | Н   |  |
|      |    |                 |                 |       |                  |                   | н                                    | н                | Н                | н                | н                | L   |  |
|      | н  | н               | н               | ;     | ×                | Х                 | x                                    | x                | Н                | Н                | Н                | н   |  |
|      |    | L               | L               | ;     | ×                | Х                 | x                                    | x                | Н                | н                | Н                | Н   |  |
|      |    | L               | н               |       | L                | L                 | x                                    | X                | L                | н                | Н                | Н   |  |
|      |    |                 |                 |       | L                | Н                 |                                      |                  | н                | L                | н                | Н   |  |
|      | 1  |                 |                 |       | -                | L                 |                                      |                  | н                | н                | L                | H   |  |
|      |    |                 |                 | H     | -                | Н                 |                                      |                  | н                | Н                | Н                | L   |  |
|      |    |                 |                 | · · · | x                | х                 | x                                    | X                | н                | н                | н                | н   |  |
|      |    | н               | L               |       | ^                |                   |                                      |                  |                  |                  |                  |     |  |
|      |    | H<br>H          | L<br>H          |       | ×                |                   |                                      |                  |                  |                  |                  |     |  |

### Unit Loading/Fan Out

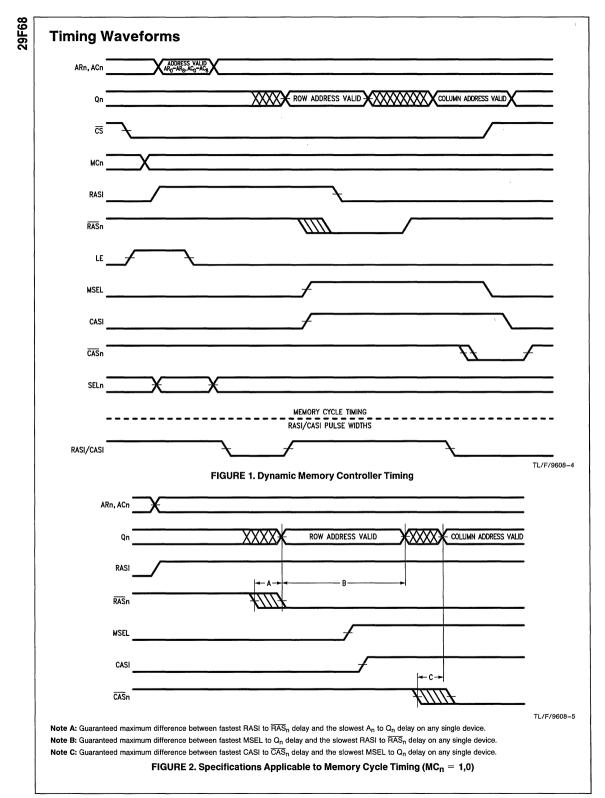
|                                       |                               | 54               | IF/74F                                                                            |
|---------------------------------------|-------------------------------|------------------|-----------------------------------------------------------------------------------|
| Pin Names                             | Description                   | U.L.<br>HIGH/LOW | Input I <sub>IH</sub> /I <sub>IL</sub><br>Output I <sub>OH</sub> /I <sub>OL</sub> |
| AC0-AC8                               | Column Address                | 1.0/1.0          | 20 μA/ – 0.6 mA                                                                   |
| AR0-AR8                               | Row Address                   | 1.0/1.0          | $20 \mu \text{A} / -0.6 \text{mA}$                                                |
| Q0-Q8                                 | Address Outputs               | 50/33.3          | —1 mA/20 mA                                                                       |
| MC <sub>0</sub> , MC <sub>1</sub>     | Memory Cycle                  | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| CS                                    | Chip Select Input             | 1.0/1.0          | 20 μA/ – 0.6 mA                                                                   |
| MSEL                                  | Multiplexer Select Input      | 1.0/1.0          | 20 μA/ 0.6 mA                                                                     |
| LE                                    | Latch Enable Input            | 1.0/1.0          | 20 μA/ – 0.6 mA                                                                   |
| SEL0, SEL1                            | Select Inputs                 | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| RASI                                  | Row Address Strobe In         | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| CASI                                  | Column Address Strobe In      | 1.0/1.0          | 20 μA/ – 0.6 mA                                                                   |
| RAS0-RAS3                             | Row Address Stobe Outputs     | 50/33.3          | —1 mA/20 mA                                                                       |
| $\overline{CAS}_0 - \overline{CAS}_3$ | Column Address Strobe Outputs | 50/33.3          | —1 mA/20 mA                                                                       |
| ŌĒ                                    | Output Enable                 | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |

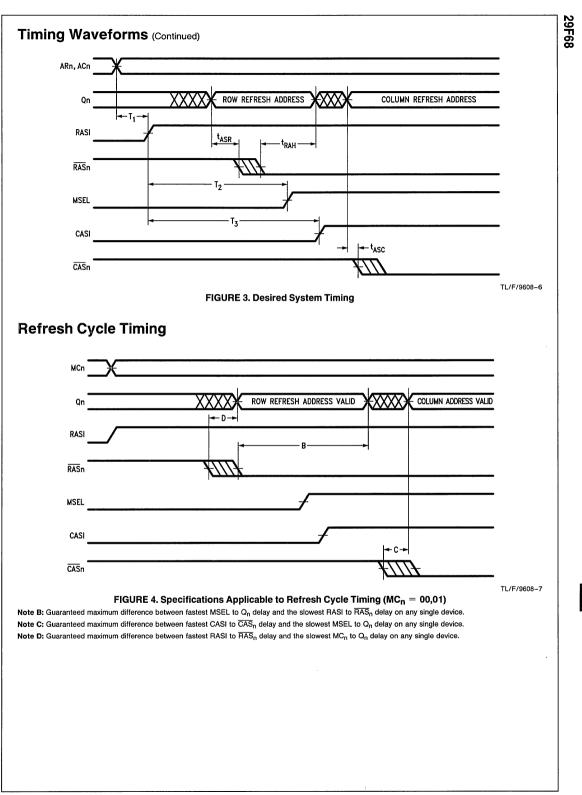
### **Block Diagram**

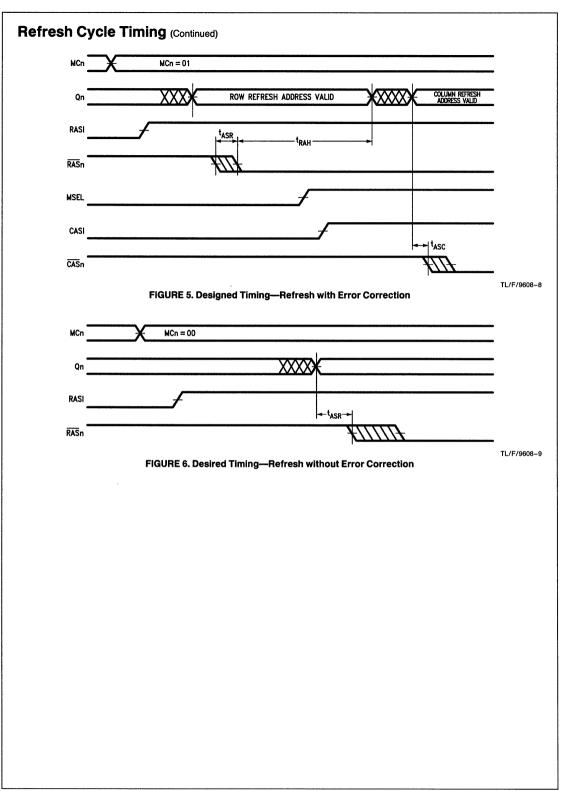


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### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| Storage Temperature                 | -65°C to +150°C                      |
|-------------------------------------|--------------------------------------|
| Ambient Temperature under Bias      | -55°C to +125°C                      |
| Junction Temperature under Bias     | -55°C to +175°C                      |
| V <sub>CC</sub> Pin Potential to    |                                      |
| Ground Pin                          | -0.5V to $+7.0V$                     |
| Input Voltage (Note 2)              | -0.5V to +7.0V                       |
| Input Current (Note 2)              | -30 mA to +5.0 mA                    |
| Voltage Applied to Output           |                                      |
| in HIGH State (with $V_{CC} = 0V$ ) |                                      |
| Standard Output                     | -0.5V to V <sub>CC</sub>             |
| TRI-STATE® Output                   | -0.5V to +5.5V                       |
| Current Applied to Output           |                                      |
| in LOW State (Max)                  | twice the rated I <sub>OL</sub> (mA) |

Note 1: Absolute (Wiax) twice the fated IOL (IMA) Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

### **DC Electrical Characteristics**

# Recommended Operating Conditions

| Free Air Ambient Temperature |                 |
|------------------------------|-----------------|
| Military                     | -55°C to +125°C |
| Commercial                   | 0°C to +70°C    |
| Supply Voltage               |                 |
| Military                     | +4.5V to +5.5V  |
| Commercial                   | +4.5V to +5.5V  |

| Symbol           | Para                              | meter                                                                                                                                                        |                                        | 54F/74F |                          | Units | v <sub>cc</sub>          | Conditions                                                                                                         |  |
|------------------|-----------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------|---------|--------------------------|-------|--------------------------|--------------------------------------------------------------------------------------------------------------------|--|
| -,               | Fala                              | ineter                                                                                                                                                       | Min                                    | Тур     | Max                      | onits | VCC                      | Conditions                                                                                                         |  |
| V <sub>IH</sub>  | Input HIGH Volt                   | age                                                                                                                                                          | 2.0                                    |         |                          | v     |                          | Recognized as a HIGH Signa                                                                                         |  |
| VIL              | Input LOW Volta                   | age                                                                                                                                                          |                                        |         | 0.8                      | v     |                          | Recognized as a LOW Signa                                                                                          |  |
| V <sub>CD</sub>  | Input Clamp Dio                   | de Voltage                                                                                                                                                   |                                        |         | -1.2                     | V     | Min                      | I <sub>IN</sub> = −18 mA                                                                                           |  |
| V <sub>OH</sub>  | Output HIGH<br>Voltage            | 54F 10% V <sub>CC</sub><br>54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 5% V <sub>CC</sub><br>74F 5% V <sub>CC</sub> | 2.5<br>2.4<br>2.5<br>2.4<br>2.7<br>2.7 |         |                          | v     | Min                      |                                                                                                                    |  |
| V <sub>OL</sub>  | Output LOW<br>Voltage             | 54F 10% V <sub>CC</sub><br>54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub>                                                     |                                        |         | 0.5<br>0.8<br>0.5<br>0.8 | v     | Min                      | $I_{OL} = 1.0 \text{ mA}$<br>$I_{OL} = 12.0 \text{ mA}$<br>$I_{OL} = 1.0 \text{ mA}$<br>$I_{OL} = 12.0 \text{ mA}$ |  |
| łн               | Input HIGH Curr                   | ent                                                                                                                                                          |                                        |         | 20                       | μA    | Max                      | $V_{IN} = 2.7V$                                                                                                    |  |
| I <sub>BVI</sub> | Input HIGH Curr<br>Breakdown Tesi |                                                                                                                                                              |                                        | 100     | μΑ                       | Max   | V <sub>IN</sub> = 7.0V   |                                                                                                                    |  |
| կլ               | Input LOW Curre                   | ent                                                                                                                                                          |                                        |         | -0.6                     | mA    | Max                      | $V_{IN} = 0.5V$                                                                                                    |  |
| I <sub>OZH</sub> | Output Leakage                    | Current                                                                                                                                                      |                                        |         | 50                       | μΑ    | Max                      | $V_{OUT} = 2.7V$                                                                                                   |  |
| I <sub>OZL</sub> | Output Leakage                    | Current                                                                                                                                                      |                                        |         | -50                      | μΑ    | Мах                      | $V_{OUT} = 0.5V$                                                                                                   |  |
| los              | Output Short-Cir                  | rcuit Current                                                                                                                                                | -60                                    |         | -150                     | mA    | Max                      | $V_{OUT} = 0V$                                                                                                     |  |
| ICEX             | Output HIGH Le                    | akage Current                                                                                                                                                |                                        |         | 250                      | μA    | Мах                      | $V_{OUT} = V_{CC}$                                                                                                 |  |
| IZZ              | Bus Drainage Te                   |                                                                                                                                                              |                                        | 500     | μΑ                       | 0.0V  | V <sub>OUT</sub> = 5.25V |                                                                                                                    |  |
| Іссн             | Power Supply C                    |                                                                                                                                                              |                                        | 300     | mA                       | Max   | V <sub>O</sub> = HIGH    |                                                                                                                    |  |
| ICCL             | Power Supply C                    |                                                                                                                                                              |                                        | 300     | mA                       | Max   | V <sub>O</sub> = LOW     |                                                                                                                    |  |
| Iccz             | Power Supply C                    | urrent                                                                                                                                                       |                                        |         | 300                      | mA    | Max                      | V <sub>O</sub> = HIGH Z                                                                                            |  |

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### **AC Electrical Characteristics**

|                                      |                                                          | 29F<br>$T_A = +25^{\circ}C$<br>$V_{CC} = +5.0V$<br>$C_L = 50 \text{ pF}$ |              |                                                                  | tary<br>9F |                                                                  |              |                                                                   |              |     |       |
|--------------------------------------|----------------------------------------------------------|--------------------------------------------------------------------------|--------------|------------------------------------------------------------------|------------|------------------------------------------------------------------|--------------|-------------------------------------------------------------------|--------------|-----|-------|
| Symbol                               | Parameter                                                |                                                                          |              | T <sub>A</sub> , V <sub>CC</sub> = Mil<br>C <sub>L</sub> = 50 pF |            | T <sub>A</sub> , V <sub>CC</sub> = Com<br>C <sub>L</sub> = 50 pF |              | T <sub>A</sub> , V <sub>CC</sub> = Com<br>C <sub>L</sub> = 500 pF |              |     | Units |
|                                      |                                                          | Min                                                                      | Max          | Min                                                              | Max        | Min                                                              | Max          | Min                                                               | Тур          | Мах |       |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>AR to Q <sub>n</sub>                | 3.0<br>3.0                                                               | 11.0<br>11.0 |                                                                  |            | 2.5<br>2.5                                                       | 12.0<br>12.0 |                                                                   | 19.0<br>22.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>AC to Q <sub>n</sub>                | 3.0<br>3.0                                                               | 11.0<br>11.0 |                                                                  |            | 2.5<br>2.5                                                       | 12.0<br>12.0 |                                                                   | 19.0<br>22.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>RASI to RAS <sub>i</sub>            | 3.5<br>3.5                                                               | 12.0<br>12.0 |                                                                  |            | 3.0<br>3.0                                                       | 13.0<br>13.0 |                                                                   | 23.0<br>20.0 |     | ns    |
| tplH<br>tpHL                         | Propagation Delay<br>CASI to CAS <sub>i</sub>            | 1.0<br>1.0                                                               | 8.0<br>8.0   |                                                                  |            | 1.0<br>1.0                                                       | 8.5<br>8.5   |                                                                   | 19.0<br>17.0 |     | ns    |
| tplH<br>tpHL                         | Propagation Delay<br>MSEL to Q <sub>n</sub>              | 3.0<br>3.0                                                               | 13.0<br>13.0 |                                                                  |            | 2.5<br>2.5                                                       | 14.0<br>14.0 |                                                                   | 24.0<br>21.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>MC <sub>n</sub> to Q <sub>n</sub>   | 4.0<br>4.0                                                               | 15.0<br>15.0 |                                                                  |            | 3.5<br>3.5                                                       | 16.0<br>16.0 |                                                                   | 25.0<br>22.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>MC <sub>n</sub> to RAS <sub>n</sub> | 3.5<br>3.5                                                               | 17.5<br>17.5 |                                                                  |            | 3.0<br>3.0                                                       | 18.5<br>18.5 |                                                                   | 24.0<br>22.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>MC <sub>n</sub> to CAS <sub>n</sub> | 4.0<br>4.0                                                               | 12.5<br>12.5 |                                                                  |            | 3.5<br>3.5                                                       | 13.5<br>13.5 |                                                                   | 23.0<br>21.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>LE to RAS <sub>n</sub>              | 4.0<br>4.0                                                               | 15.0<br>15.0 |                                                                  |            | 3.5<br>3.5                                                       | 16.0<br>16.0 |                                                                   | 25.0<br>24.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>LE to CAS <sub>n</sub>              | 5.0<br>5.0                                                               | 13.5<br>13.5 |                                                                  |            | 4.5<br>4.5                                                       | 14.5<br>14.5 |                                                                   | 24.0<br>24.0 |     | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>LE to Q <sub>n</sub>                | 3.5<br>3.5                                                               | 12.0<br>12.0 |                                                                  |            | 3.0<br>3.0                                                       | 13.0<br>13.0 |                                                                   | 23.0<br>22.0 |     | ns    |

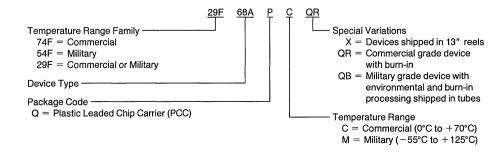
|                                          |                                                                 | 29                                                              | θF         | Milita                                                           | ry 29F | Comme                                                | rcial 29F    |    |
|------------------------------------------|-----------------------------------------------------------------|-----------------------------------------------------------------|------------|------------------------------------------------------------------|--------|------------------------------------------------------|--------------|----|
| Symbol                                   | Parameter                                                       | $T_{A} = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_{L} = 50 \text{ pF}$ |            | T <sub>A</sub> , V <sub>CC</sub> = Mil<br>C <sub>L</sub> = 50 pF |        | T <sub>A</sub> , V <sub>CC</sub><br>C <sub>L</sub> = | Units        |    |
|                                          |                                                                 | Min                                                             | Max        | Min                                                              | Max    | Min                                                  | Max          |    |
| t <sub>PZH</sub><br>t <sub>PZL</sub>     | Output Disable Time<br>OE to Q <sub>n</sub>                     | 1.0<br>1.0                                                      | 9.5<br>9.5 |                                                                  |        | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PZH</sub><br>t <sub>PZL</sub>     | Output Disable Time<br>OE to Q <sub>n</sub>                     | 1.0<br>1.0                                                      | 9.5<br>9.5 |                                                                  |        | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub>     | Output Disable Time<br>OE to RAS <sub>n</sub>                   | 1.0<br>1.0                                                      | 9.5<br>9.5 |                                                                  |        | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PZH</sub><br>t <sub>PZL</sub>     | Output Disable Time<br>OE to RAS <sub>n</sub>                   | 1.0<br>1.0                                                      | 9.5<br>9.5 |                                                                  |        | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub>     | Output Disable Time<br>OE to CAS <sub>n</sub>                   | 1.0<br>1.0                                                      | 9.5<br>9.5 |                                                                  |        | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PZH</sub><br>t <sub>PZL</sub>     | Output Enable Time<br>OE to CAS <sub>n</sub>                    | 1.0<br>1.0                                                      | 9.5<br>9.5 |                                                                  |        | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>w</sub> (H)<br>t <sub>w</sub> (L) | Pulse Width, HIGH or LOW<br>CAS <sub>n</sub> , RAS <sub>n</sub> | 15.0<br>15.0                                                    |            |                                                                  |        | 15.0<br>15.0                                         |              | ns |
| t <sub>skew</sub>                        | Q <sub>n</sub> to CAS <sub>n</sub> , RAS <sub>n</sub>           |                                                                 | 10.0       |                                                                  |        |                                                      | 10.0         | ns |

### **AC Operating Requirements**

|                                          |                                                 | 2          | 9F               | Militar                          | y 29F   | Comme                                  |     |    |
|------------------------------------------|-------------------------------------------------|------------|------------------|----------------------------------|---------|----------------------------------------|-----|----|
| Symbol                                   | Parameter                                       |            | + 25°C<br>+ 5.0V | T <sub>A</sub> , V <sub>CC</sub> | ; = Mil | T <sub>A</sub> , V <sub>CC</sub> = Com |     |    |
|                                          |                                                 | Min        | Max              | Min                              | Мах     | Min                                    | Max |    |
| t <sub>s</sub> (H)<br>t <sub>s</sub> (L) | Setup Time, HIGH or LOW<br>A <sub>n</sub> to LE | 5.0<br>5.0 |                  |                                  |         | 5.0<br>5.0                             |     | ns |
| t <sub>h</sub> (H)<br>t <sub>h</sub> (L) | Hold Time, HIGH or LOW<br>A <sub>n</sub> to LE  | 5.0<br>5.0 |                  |                                  |         | 5.0<br>5.0                             |     | ns |
| t <sub>s</sub> (H)<br>t <sub>s</sub> (L) | Setup Time, HIGH or LOW<br>SEL to LE            | 5.0<br>5.0 |                  |                                  |         | 5.0<br>5.0                             |     | ns |
| t <sub>h</sub> (H)<br>t <sub>h</sub> (L) | Hold Time, HIGH or LOW<br>SEL to LE             | 5.0<br>5.0 |                  |                                  |         | 5.0<br>5.0                             |     | ns |

### **Ordering Information**

The device number is used to form part of a simplified purchasing code where a package type and temperature range are defined as follows:



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National Semiconductor

### 54F/74F968 1 Mbit Dynamic RAM Controller

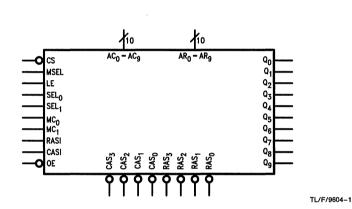
### **General Description**

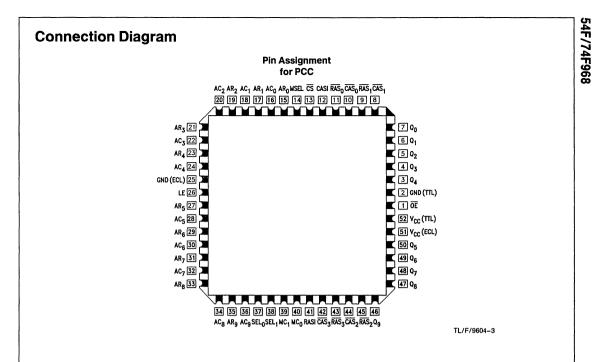
The 'F968 is a high performance memory controller, replacing many SSI and MSI devices by grouping several unique functions. It provides two 10-bit address latches and two 10bit counters for row and column address generation during refresh. A 2-bit bank select latch for row and column address generation during refresh and a 2-bit bank select latch for the two high order address bits are provided to select one of the four RAS and CAS outputs.

### Logic Symbol

### **Features**

- Provides control for 16k, 64k, 256k or 1 Mbit DRAM systems
- Outputs directly drive up to 88 DRAMs
- Chip select for easy expansion
- Provides memory refresh with error correction mode
- 52-pin plastic leaded chip carrier





### Unit Loading/Fan Out

|                                       |                               | 54               | IF/74F                                                                            |
|---------------------------------------|-------------------------------|------------------|-----------------------------------------------------------------------------------|
| Pin Names                             | Description                   | U.L.<br>HIGH/LOW | Input I <sub>IH</sub> /I <sub>IL</sub><br>Output I <sub>OH</sub> /I <sub>OL</sub> |
| AC0-AC9                               | Column Address Inputs         | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| AR0-AR9                               | Row Address Inputs            | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| MC <sub>0</sub> , MC <sub>1</sub>     | Mode Control Inputs           | 1.0/1.0          | $20 \mu \text{A} / -0.6 \text{mA}$                                                |
| CS                                    | Chip Select Input             | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| MSEL                                  | Multiplexer Select Input      | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| LE                                    | Latch Enable Input            | 1.0/1.0          | 20 μA/ – 0.6 mA                                                                   |
| SEL0, SEL1                            | Bank Select Inputs            | 1.0/1.0          | 20 µA/ - 0.6 mA                                                                   |
| RASI                                  | Row Address Strobe In         | 1.0/1.0          | $20 \mu A / - 0.6 m A$                                                            |
| CASI                                  | Column Address Strobe In      | 1.0/1.0          | 20 µA/ - 0.6 mA                                                                   |
| ŌĒ                                    | Output Enable                 | 1.0/1.0          | 20 µA/−0.6 mA                                                                     |
| RAS0-RAS3                             | Row Address Strobe Outputs    | 150/1.667        | -3 mA/1.0 mA                                                                      |
| $\overline{CAS}_0 - \overline{CAS}_3$ | Column Address Strobe Outputs | 150/1.667        | -3 mA/1.0 mA                                                                      |
| Q <sub>0</sub> -Q <sub>9</sub>        | Address Outputs               | 150/1.667        | -3 mA/1.0 mA                                                                      |

### **Pin Description**

| Name                                                                 | 1/0 | Description                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|----------------------------------------------------------------------|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AR <sub>0</sub> -AR <sub>9</sub><br>AC <sub>0</sub> -AC <sub>9</sub> | Ι   | Address Inputs. $AR_0-AR_9$ are latched in as the 10-bit Row Address for the RAM. These inputs drive $Q_0-Q_9$ when the 'F968 is in the Read/Write mode and MSEL is LOW. $AC_0-AC_9$ are latched in as the Column Address, and will drive $Q_0-Q_9$ when MSEL is HIGH and the 'F968 is in the Read/Write mode. The addresses are latched with the Latch Enable (LE) signal.                                                                     |
| SEL0-SEL1                                                            | Ι   | Bank Select. These two inputs are normally the two higher order address bits, and are used in the Read/Write mode to select which bank of memory will be receiving the RAS <sub>n</sub> and CAS <sub>n</sub> signals after RASI and CASI go HIGH.                                                                                                                                                                                               |
| LE                                                                   | 1   | Latch Enable. This active-HIGH input causes the Row, Column and Bank Select latches to become<br>transparent, allowing the latches to accept new input data. A LOW input on LE latches the input data,<br>assuming it meets the setup and hold time requirements.                                                                                                                                                                               |
| MSEL                                                                 | I   | Multiplexer Select. This input determines whether the Row or Column Address will be sent to the memory<br>address inputs. When MSEL is HIGH the Column Address is selected, while the Row Address is selected<br>when MSEL is LOW. The address may come from either the address latch or refresh address counter<br>depending on MC <sub>0</sub> , MC <sub>1</sub> .                                                                            |
| CS                                                                   | 1   | <b>Chip Select.</b> This active-LOW input is used to enable the 'F968. When $\overline{CS}$ is active, the 'F968 operates normally in all four modes. When $\overline{CS}$ goes HIGH, the device will not enter the Read/Write mode. This allows other devices to access the same memory that the 'F968 is controlling (e.g., DMA controller,.                                                                                                  |
| ŌĒ                                                                   | Ι   | <b>Output Enable.</b> This active-LOW input enables/disables the output signals. When $\overline{OE}$ is HIGH, the output of the 'F968 enter the high impedance state. The $\overline{OE}$ signal allows more than one 'F968 to control the same memory, thus providing an easy method to expand the memory size.                                                                                                                               |
| MC <sub>0</sub> , MC <sub>1</sub>                                    | 1   | <b>Mode Control.</b> These inputs are used to specify which of the four operating modes the 'F968 should be using. The description of the four operating modes is given in the Mode Control Function Table.                                                                                                                                                                                                                                     |
| Q <sub>0</sub> –Q <sub>9</sub>                                       | 0   | Address Outputs. These address outputs will feed the DRAM address inputs and provide drive for<br>memory systems up to 500 pF in capacitance.                                                                                                                                                                                                                                                                                                   |
| RASI                                                                 | I   | <b>Row Address Strobe Input.</b> During normal memory cycles, the decoded $\overline{RAS}_n$ output ( $\overline{RAS}_0$ , $\overline{RAS}_1$ , $\overline{RAS}_2$ or $\overline{RAS}_3$ ) is forced LOW after receipt of RASI. In either refresh mode, all four $\overline{RAS}_n$ outputs will go LOW following RASI going HIGH.                                                                                                              |
| RAS <sub>0</sub> -RAS <sub>3</sub>                                   | 0   | <b>Row Address Strobe.</b> Each one of the Row Address Strobe outputs provides a $\overline{RAS}_n$ signal to one of the four banks of dynamic memory. Each will go LOW only when selected by SEL <sub>0</sub> and SEL <sub>1</sub> and only after RASI goes HIGH. All four go LOW in response to RASI in either of the Refresh modes.                                                                                                          |
| CASI                                                                 | Ι   | Column Address Strobe Input. This input going active will cause the selected $\overline{CAS}_n$ output to be forced LOW.                                                                                                                                                                                                                                                                                                                        |
| CAS <sub>0</sub> -CAS <sub>3</sub>                                   | 0   | <b>Column Address Strobe.</b> During normal Read/Write cycles the two select bits (SEL <sub>0</sub> , SEL <sub>1</sub> ) determine which $\overline{CAS}_n$ output will go active following CASI going HIGH. When memory error correction is performed, only the $\overline{CAS}_n$ signal selected by CNTR <sub>0</sub> and CNTR <sub>1</sub> will be active. For non-error correction cycles, all fou $\overline{CAS}_n$ outputs remain HIGH. |

54F/74F968

### **Functional Description**

The 74F968 is a 1 Mbit DRAM controller which is functionally equivalent to AMD's Am29368. The 74F968 provides row-/column address multiplexing, refresh address generation and bank selection for up to four banks of RAMs.

Twenty-two (22) address bits  $(AR_0-AR_9, AC_0-AC_9 \text{ and} bank select addresses SEL_0 and SEL_1) are presented to the controller. These addresses are latched by a 22-bit latch. A 22-bit counter generates the refresh address.$ 

A 10-bit multiplexer selects the output address between the input row address, column address, refresh counter row address, column address, or zero (clear). Four RAS and four CAS outputs select the appropriate bank of RAMs and strobe in the row and column addresses.

It should be noted that the counters are cleared ( $MC_0$ ,  $MC_1 = 1$ , 1) on the next RASI transition, but the Q outputs are asynchronously cleared through the multiplexer.

|                 |     | Mode Control Function Table                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |  |  |  |  |  |  |  |  |
|-----------------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|--|--|--|
| MC <sub>1</sub> | MCo | Operating Mode                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |  |  |  |  |  |  |  |  |
| L               | L   | <b>Refresh without Error Correction</b> — Refresh cycles are performed with only the Row Counter being used to generate addresses. In this mode, all four $\overline{RAS}_n$ outputs are active while the four $\overline{CAS}_n$ signals are kept HIGH.                                                                                                                                                                                                                                                                                                       |  |  |  |  |  |  |  |  |
| L               | н   | <b>Refresh with Error Correction/Initialize</b> — During this mode, refresh cycles are done with both the Row and Column counters generating the addresses. MSEL is used to select between the Row and Column counter. All four $\overline{RAS}_n$ outputs go active in response to RASI, while only one $\overline{CAS}_n$ output goes LOW in response to CASI. The Bank Counter keeps track of which $\overline{CAS}_n$ output will go active. This mode of operation is possible when supported by an error detection/correction circuit such as the 'F632. |  |  |  |  |  |  |  |  |
| н               | L   | <b>Read/Write</b> — This mode is used to perform Read/Write cycles. Both the Row and Column addresses are latched and multiplexed to the address output lines using MSEL; SEL <sub>0</sub> and SEL <sub>1</sub> are decoded to determine which $\overline{\text{RAS}}_n$ and $\overline{\text{CAS}}_n$ will be active.                                                                                                                                                                                                                                         |  |  |  |  |  |  |  |  |
| н               | Н   | <b>Clear Refresh Counter</b> — This mode will clear the three refresh counters (Row, Column and Bank) on the HIGH-to-LOW transition of RASI, putting them at the start of the refresh sequence. In this mode, all four $\overline{RAS}_n$ outputs are driven LOW upon receipt of RASI so that DRAM wake-up cycles are performed. This mode also asynchronously clears the $Q_n$ outputs.                                                                                                                                                                       |  |  |  |  |  |  |  |  |

H = HIGH Voltage Level L = LOW Voltage Level

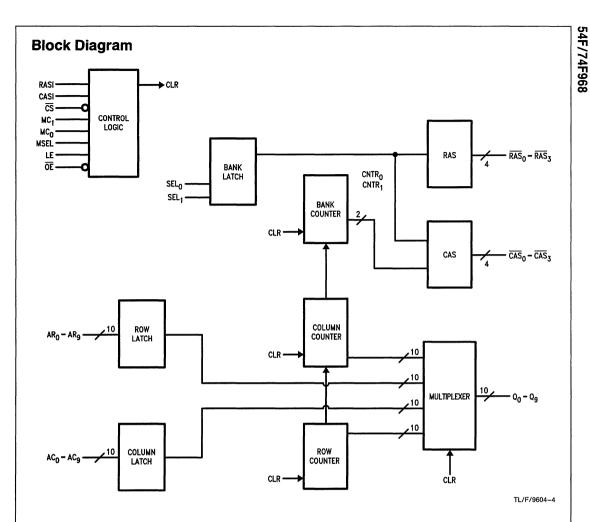
### Address Output Function Table

| <del>CS</del> | MC <sub>1</sub> | MCo | MSEL | Mode                             | MUX Output             |  |
|---------------|-----------------|-----|------|----------------------------------|------------------------|--|
|               | L               | L   | х    | Refresh without Error Correction | Row Counter Address    |  |
|               | ŀ               | н   | н    | Refresh with Error Correction    | Column Counter Address |  |
| 1             |                 |     | L    |                                  | Row Counter Address    |  |
| L             | Н               | I   | н    | Read/Write                       | Column Address Latch   |  |
|               | 11              |     | L    |                                  | Row Address Latch      |  |
|               | н               | Н   | х    | Clear Refresh Counter            | Zero                   |  |
|               | L               | L   | х    | Refresh without Error Correction | Row Counter Address    |  |
|               |                 | н   | н    | Refresh with Error Correction    | Column Counter Address |  |
| н             |                 |     | L    |                                  | Row Counter Address    |  |
|               | н               | L   | х    | Read/Write                       | Zero                   |  |
|               | н               | н   | х    | Clear Refresh Counter            | Zero                   |  |

H = HIGH Voltage Level

L = LOW Voltage Level X = Immaterial 54F/74F968

| RASI | CS | MC <sub>1</sub>                                                                                                                                                                                                                                                                                                                                                                                                           | MC <sub>0</sub> | SEL1 | SEL0             |                   | Mode             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | RAS <sub>0</sub>                                                                                        | RAS <sub>1</sub> | RAS <sub>2</sub> | RAS              |   |   |
|------|----|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------|------------------|-------------------|------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------|------------------|------------------|------------------|---|---|
| L    | х  | х                                                                                                                                                                                                                                                                                                                                                                                                                         | х               | Х    | X                | Non-Refr          | esh              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | н                | н                | н                |   |   |
|      |    | LL                                                                                                                                                                                                                                                                                                                                                                                                                        |                 | Х    | x                | Refresh w         | vithout Erro     | r Correction                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | L                                                                                                       | L                | L                | L                |   |   |
|      |    | L                                                                                                                                                                                                                                                                                                                                                                                                                         | н               | х    | x                | Refresh w         | ith Error Co     | orrection                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | L                                                                                                       | L                | L                | L                |   |   |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 | L    | L                | Read/Wr           | ite              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | L                                                                                                       | н                | н                | н                |   |   |
|      | L  | н                                                                                                                                                                                                                                                                                                                                                                                                                         | ,               | L    | н                |                   |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | L                | Н                | н                |   |   |
| н    |    |                                                                                                                                                                                                                                                                                                                                                                                                                           | -               | н    | L                |                   |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | н                | L                | н                |   |   |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           | н               | н    |                  |                   |                  | н                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | н                | L                |                  |   |   |
|      |    | н                                                                                                                                                                                                                                                                                                                                                                                                                         | н               | х    | x                | Clear Ref         | resh Count       | er                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | L                                                                                                       | L                | L                | L                |   |   |
|      |    | L                                                                                                                                                                                                                                                                                                                                                                                                                         | L               | х    | x                | Refresh w         | vithout Erro     | r Correction                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | L                                                                                                       | L                | L                | L                |   |   |
|      | н  | L                                                                                                                                                                                                                                                                                                                                                                                                                         | н               |      |                  | Refresh w         | vith Error Co    | orrection                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | L                                                                                                       | L                | L                | L                |   |   |
|      |    | н                                                                                                                                                                                                                                                                                                                                                                                                                         | L               |      |                  | Read/Wr           | ite              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | н                | н                | н                |   |   |
|      |    | н                                                                                                                                                                                                                                                                                                                                                                                                                         | Н               |      |                  | Clear Ref         | resh Count       | er                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | L                                                                                                       | L                | L                | L                |   |   |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      | C                | AS Output Fi      | unction Tal      | ble                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                                         |                  |                  |                  |   |   |
|      | Ir | puts                                                                                                                                                                                                                                                                                                                                                                                                                      |                 | 1    | nternal (        | Counter           | Inp              | uts                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                                         | Outputs          |                  |                  |   |   |
| CASI | CS | MC <sub>1</sub>                                                                                                                                                                                                                                                                                                                                                                                                           | MCo             |      | ITR <sub>1</sub> | CNTR <sub>0</sub> | SEL <sub>1</sub> | SEL <sub>0</sub>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | CAS <sub>0</sub>                                                                                        |                  | CAS <sub>2</sub> | CAS <sub>3</sub> |   |   |
|      |    | L                                                                                                                                                                                                                                                                                                                                                                                                                         | L               |      | х                | х                 | х                | x                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | н                | Н                | н                |   |   |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      | L                | L                 |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | L                                                                                                       | н                | н                | Н                |   |   |
|      |    | L                                                                                                                                                                                                                                                                                                                                                                                                                         | н               |      | L                |                   | x                | x                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | L                | н                | н                |   |   |
|      |    | -                                                                                                                                                                                                                                                                                                                                                                                                                         |                 |      | н                | L                 |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | н                | L                | н                |   |   |
|      | L  |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      | н                | н                 |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | н                | н                | L                |   |   |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      | ,                |                   | L                | L                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | Outputs       CAS0     CAS1       CAS0     CAS1       H     H       L     H       H     L       H     H | н                | н                |                  |   |   |
|      |    | н                                                                                                                                                                                                                                                                                                                                                                                                                         | н               | Н    | L                |                   |                  | х                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | L                                                                                                       | н                | н                | L                | н | н |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      |                  |                   | н                | RAS0         RAS1           H         H           r Correction         L         L           prection         L         H           I         H         H           prection         L         H           I         H         H           prection         L         H           I         H         H           H         H         L           H         H         H           P         L         L           H         H         H           P         L         L           r Correction         L         L           prection         CAS0         CAS1         G           X         H         H         H           X         H         H         H           X         H         H         H           X         H         H         H           H         H         H | L                                                                                                       | н                |                  |                  |   |   |
| н    |    | XXXXNon-RefreshHLLXXRefresh without Error CorrectionLLHXXRefresh with Error CorrectionLHHXXRefresh with Error CorrectionLHLHHHHHLHHHXXClear Refresh CounterLLLXXClear Refresh without Error CorrectionLLHKXClear Refresh without Error CorrectionLHHKXRefresh without Error CorrectionLHHKXXRefresh without Error CorrectionLHHKXXXHHHKXXXHHHKXXXHHHLLLLLLLXXXHHHHHHHHHKXXHHHKXXHHHXXXXHHHXXXXHHHKXXXHHHKKKHHHHKKKHHHKKKH | н               | н    | н                | L                 |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                         |                  |                  |                  |   |   |
|      |    | н                                                                                                                                                                                                                                                                                                                                                                                                                         | н               |      | x                | х                 | x                | x                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | Н                | н                | н                |   |   |
|      |    | L                                                                                                                                                                                                                                                                                                                                                                                                                         | L               |      | х                | Х                 | x                | x                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | н                | Н                | н                |   |   |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      | L                | L                 |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | L                                                                                                       | н                | н                | н                |   |   |
|      |    | L                                                                                                                                                                                                                                                                                                                                                                                                                         | Н               |      | L                | Н                 | x                | x                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | L                | Н                | н                |   |   |
|      | н  |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      | н                | L                 |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | н                | L                | н                |   |   |
|      |    |                                                                                                                                                                                                                                                                                                                                                                                                                           |                 |      | н                | Н                 |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | н                                                                                                       | н                | н                | L                |   |   |
|      |    | н                                                                                                                                                                                                                                                                                                                                                                                                                         | L               |      | x                | x                 | x                | x                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | н                | н                | н                |   |   |
|      |    | н                                                                                                                                                                                                                                                                                                                                                                                                                         | н               |      |                  |                   |                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                         |                  |                  |                  |   |   |
| L    | x  | X                                                                                                                                                                                                                                                                                                                                                                                                                         | X               |      | x                | х                 | X                | x                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | н                                                                                                       | н                | н                | н                |   |   |



### **Memory Cycle Timing**

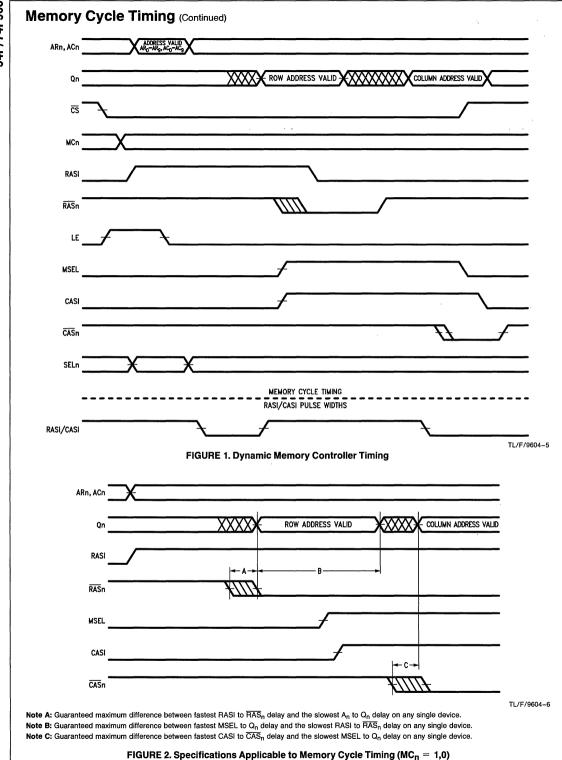
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The relationship between the 'F968 specifications and system timing requirements is shown in *Figures 1–6.* T1, T2 and T3 represent the minimum timing requirements at the 'F968 inputs to guarantee that the RAM timing requirements are met and that maximum system performance is achieved.

The minimum requirement for T1, T2 and T3 are as follows:

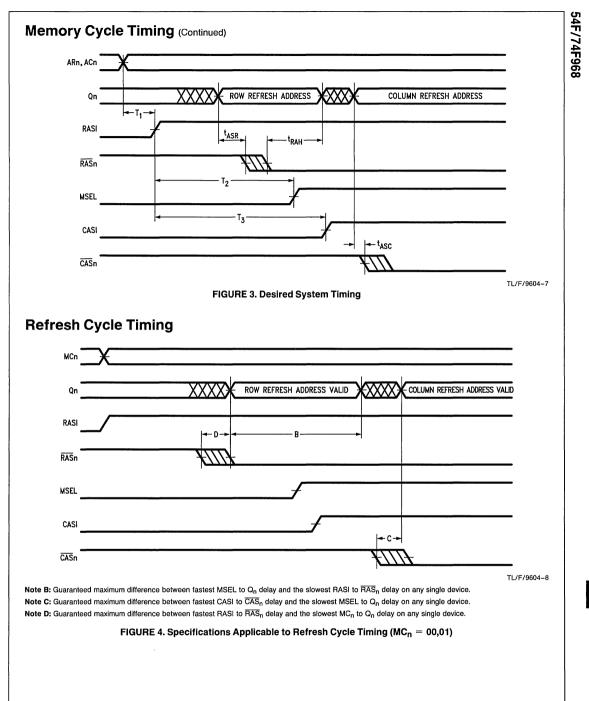
T3 Min = T2 +  $t_{skew}$  +  $t_{ASC}$ .

See RAM data sheet for applicable values for  $t_{\text{RAH}},\,t_{\text{ASC}}$  and  $t_{\text{ASR}}.$ 

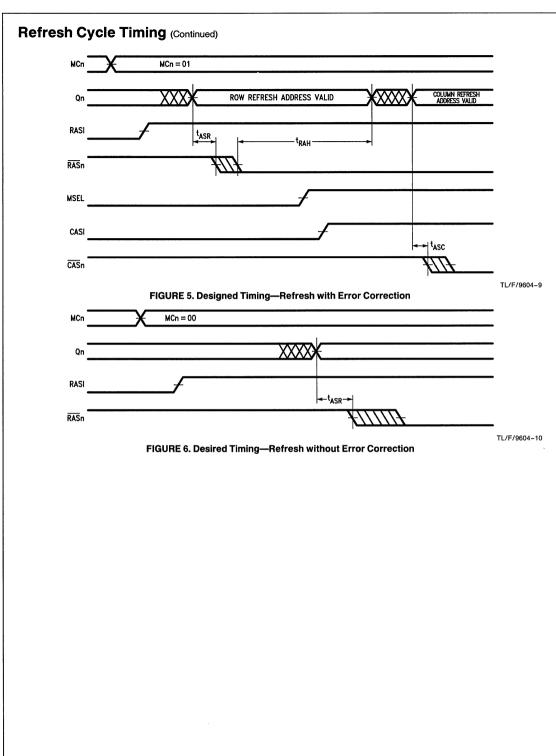


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# 54F/74F968



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### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| Storage Temperature                                              | -65°C to +150°C          |
|------------------------------------------------------------------|--------------------------|
| Ambient Temperature under Bias                                   | -55°C to +125°C          |
| Junction Temperature under Bias                                  | -55°C to +175°C          |
| V <sub>CC</sub> Pin Potential to                                 |                          |
| Ground Pin                                                       | -0.5V to $+7.0V$         |
| Input Voltage (Note 2)                                           | -0.5V to $+7.0V$         |
| Input Current (Note 2)                                           | -30 mA to +5.0 mA        |
| Voltage Applied to Output<br>in HIGH State (with $V_{CC} = 0V$ ) |                          |
| Standard Output                                                  | -0.5V to V <sub>CC</sub> |
| 3-State Output                                                   | -0.5V to $+5.5V$         |

### Current Applied to Output in LOW State (Max)

twice the rated IOL (mA)

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# Recommended Operating Conditions

Free Air Ambient Temperature Military

-55°C to +125°C 0°C to +70°C

Commercial Supply Voltage Military Commercial

+ 4.5V to + 5.5V + 4.5V to + 5.5V

## **DC Electrical Characteristics**

| Symbol           | Parama                               | Parameter 54F/74F<br>Min Typ Max                                                                                                                             |                                        | 54F/74F Units Vo |                          | vcc | Conditions |                                                                                                                                                       |
|------------------|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------|------------------|--------------------------|-----|------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|
| Symbol           | Farame                               |                                                                                                                                                              |                                        | Max              |                          | VCC | Conditions |                                                                                                                                                       |
| VIH              | Input HIGH Voltage                   |                                                                                                                                                              | 2.0                                    |                  |                          | v   |            | Recognized as a HIGH Signal                                                                                                                           |
| VIL              | Input LOW Voltage                    |                                                                                                                                                              |                                        |                  | 0.8                      | v   |            | Recognized as a LOW Signal                                                                                                                            |
| V <sub>CD</sub>  | Input Clamp Diode Vo                 | oltage                                                                                                                                                       |                                        |                  | -1.2                     | v   | Min        | l <sub>IN</sub> = -18 mA                                                                                                                              |
| V <sub>OH</sub>  | Output HIGH<br>Voltage               | 54F 10% V <sub>CC</sub><br>54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 5% V <sub>CC</sub><br>74F 5% V <sub>CC</sub> | 2.5<br>2.4<br>2.5<br>2.4<br>2.7<br>2.7 |                  |                          | v   | Min        | $l_{OH} = -1 \text{ mA}$ $l_{OH} = -3 \text{ mA}$ $l_{OH} = -1 \text{ mA}$ $l_{OH} = -3 \text{ mA}$ $l_{OH} = -1 \text{ mA}$ $l_{OH} = -3 \text{ mA}$ |
| V <sub>OL</sub>  | Output LOW<br>Voltage                | 54F 10% V <sub>CC</sub><br>54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub>                                                     |                                        |                  | 0.5<br>0.8<br>0.5<br>0.8 | v   | Min        | $I_{OL} = 1.0 \text{ mA}$<br>$I_{OL} = 12 \text{ mA}$<br>$I_{OL} = 1.0 \text{ mA}$<br>$I_{OL} = 12 \text{ mA}$                                        |
| lін              | Input HIGH<br>Current                | 54F<br>74F                                                                                                                                                   |                                        |                  | 20.0<br>5.0              | μΑ  | Max        | V <sub>IN</sub> = 2.7V                                                                                                                                |
| IBNI             | Input HIGH Current<br>Breakdown Test | 54F<br>74F                                                                                                                                                   |                                        |                  | 100<br>7.0               | μΑ  | Max        | V <sub>IN</sub> = 7.0V                                                                                                                                |
| ICEX             | Output HIGH<br>Leakage Current       | 54F<br>74F                                                                                                                                                   |                                        |                  | 250<br>50                | μΑ  | Max        | $V_{OUT} = V_{CC}$                                                                                                                                    |
| V <sub>ID</sub>  | Input Leakage<br>Test                | 74F                                                                                                                                                          | 4.75                                   |                  |                          | v   | 0.0        | l <sub>ID</sub> = 1.9 μA<br>All Other Pins Grounded                                                                                                   |
| I <sub>OD</sub>  | Output Leakage<br>Circuit Current    | 74F                                                                                                                                                          |                                        |                  | 3.75                     | μΑ  | 0.0        | V <sub>IOD</sub> = 150 mV<br>All Other Pins Grounded                                                                                                  |
| Ι <sub>ΙL</sub>  | Input LOW Current                    |                                                                                                                                                              |                                        |                  | -0.6                     | mA  | Max        | $V_{IN} = 0.5V$                                                                                                                                       |
| I <sub>OZH</sub> | Output Leakage Curre                 | ent                                                                                                                                                          |                                        |                  | 50                       | μΑ  | Max        | $V_{OUT} = 2.7V$                                                                                                                                      |
| lozl             | Output Leakage Curre                 | ent                                                                                                                                                          |                                        |                  | -50                      | μΑ  | Max        | V <sub>OUT</sub> = 0.5V                                                                                                                               |
| los              | Output Short-Circuit C               | Current                                                                                                                                                      | -60                                    |                  | - 150                    | mA  | Max        | $V_{OUT} = 0V$                                                                                                                                        |
| I <sub>ZZ</sub>  | Buss Drainage Test                   |                                                                                                                                                              |                                        |                  | 500                      | μA  | 0.0V       | V <sub>OUT</sub> = 5.25V                                                                                                                              |
| I <sub>CCH</sub> | Power Supply Current                 | t                                                                                                                                                            |                                        | 1 2123.2         | 300                      | mA  | Max        | V <sub>O</sub> = HIGH                                                                                                                                 |
| I <sub>CCL</sub> | Power Supply Current                 | t                                                                                                                                                            |                                        |                  | 300                      | mA  | Max        | V <sub>O</sub> = LOW                                                                                                                                  |
| I <sub>CCZ</sub> | Power Supply Current                 | t                                                                                                                                                            |                                        |                  | 300                      | mA  | Max        | V <sub>O</sub> = HIGH Z                                                                                                                               |

### **AC Electrical Characteristics**

|                                      | Parameter                                                 | 74F                                                                         |             |              |            |                |                                                                    |     |       |  |
|--------------------------------------|-----------------------------------------------------------|-----------------------------------------------------------------------------|-------------|--------------|------------|----------------|--------------------------------------------------------------------|-----|-------|--|
| Symbol                               |                                                           | T <sub>A</sub> = +25°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |             |              |            | = Com<br>50 pF | T <sub>A</sub> , V <sub>CC</sub> = Com<br>C <sub>L</sub> = 500 pF* |     | Units |  |
|                                      |                                                           | Min                                                                         | Тур         | Max          | Min        | Max            | Min Typ                                                            | Max |       |  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>AR to Q <sub>n</sub>                 | 3.0<br>3.0                                                                  | 7.0<br>7.0  | 11.0<br>11.0 | 2.5<br>2.5 | 12.0<br>12.0   | 19.0<br>22.0                                                       |     | ns    |  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>AC to Q <sub>n</sub>                 | 3.0<br>3.0                                                                  | 7.0<br>7.0  | 11.0<br>11.0 | 2.5<br>2.5 | 12.0<br>12.0   | 19.0<br>22.0                                                       |     | ns    |  |
| <sup>E</sup> PLH<br>EPHL             | Propagation Delay<br>RASI to RAS <sub>n</sub>             | 3.5<br>3.5                                                                  | 8.0<br>7.0  | 12.0<br>12.0 | 3.0<br>3.0 | 13.0<br>13.0   | 23.0<br>20.0                                                       |     | ns    |  |
| <sup>I</sup> PLH<br><sup>I</sup> PHL | Propagation Delay<br>CASI to CAS <sub>n</sub>             | 1.0<br>1.0                                                                  | 6.0<br>4.0  | 8.0<br>8.0   | 1.0<br>1.0 | 8.5<br>8.5     | 19.0<br>17.0                                                       |     | ns    |  |
| <sup>I</sup> PLH<br><sup>I</sup> PHL | Propagation Delay<br>MSEL to Q <sub>n</sub>               | 3.0<br>3.0                                                                  | 9.0<br>8.0  | 13.0<br>13.0 | 2.5<br>2.5 | 14.0<br>14.0   | 24.0<br>21.0                                                       |     | ns    |  |
| <sup>I</sup> PLH<br><sup>I</sup> PHL | Propagation Delay<br>MC <sub>n</sub> to Q <sub>n</sub>    | 4.0<br>4.0                                                                  | 10.0<br>9.0 | 15.0<br>15.0 | 3.5<br>3.5 | 16.0<br>16.0   | 25.0<br>22.0                                                       |     | ns    |  |
| t <sub>PLH</sub>                     | Propagation Delay<br>MC <sub>n</sub> to RAS <sub>n</sub>  | 3.5<br>3.5                                                                  | 11.0<br>8.0 | 17.5<br>17.5 | 3.0<br>3.0 | 18.5<br>18.5   | 24.0<br>22.0                                                       |     | ns    |  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay $MC_n$ to $\overline{CAS}_n$            | 4.0<br>4.0                                                                  | 8.0<br>9.0  | 12.5<br>12.5 | 3.5<br>3.5 | 13.5<br>13.5   | 23.0<br>21.0                                                       |     | ns    |  |
| <sup>I</sup> PLH<br><sup>I</sup> PHL | Propagation Delay<br>LE to RAS <sub>n</sub>               | 4.0<br>4.0                                                                  | 10.0<br>9.0 | 15.0<br>15.0 | 3.5<br>3.5 | 16.0<br>16.0   | 25.0<br>24.0                                                       |     | ns    |  |
| <sup>t</sup> PLH<br>t <sub>PHL</sub> | Propagation Delay<br>LE to CAS <sub>n</sub>               | 5.0<br>5.0                                                                  | 9.0<br>9.0  | 13.5<br>13.5 | 4.5<br>4.5 | 14.5<br>14.5   | 24.0<br>24.0                                                       |     | ns    |  |
| <sup>l</sup> PLH<br><sup>l</sup> PHL | Propagation Delay<br>LE to Q <sub>n</sub>                 | 3.5<br>3.5                                                                  | 8.0<br>7.0  | 12.0<br>12.0 | 3.0<br>3.0 | 13.0<br>13.0   | 23.0<br>22.0                                                       |     | ns    |  |
| <sup>l</sup> PLH<br><sup>l</sup> PHL | Propagation Delay $\overline{CS}$ to $Q_n$                | 3.0<br>3.0                                                                  | 10.0<br>8.0 | 14.5<br>14.5 | 3.0<br>3.0 | 15.5<br>15.5   | 25.0<br>23.0                                                       |     | ns    |  |
| PLH<br>PHL                           | Propagation Delay<br>CS to RAS <sub>n</sub>               | 3.5<br>3.5                                                                  | 8.0<br>8.0  | 13.0<br>13.0 | 3.0<br>3.0 | 14.0<br>14.0   | 23.0<br>23.0                                                       |     | ns    |  |
| PLH<br>PHL                           | Propagation Delay<br>CS to CAS <sub>n</sub>               | 4.0<br>4.0                                                                  | 8.0<br>8.0  | 11.5<br>11.5 | 3.5<br>3.5 | 12.5<br>12.5   | 23.0<br>23.0                                                       |     | ns    |  |
| PLH<br>PHL                           | Propagation Delay<br>SEL <sub>n</sub> to RAS <sub>n</sub> | 4.0<br>4.0                                                                  | 9.0<br>8.0  | 15.5<br>15.5 | 3.5<br>3.5 | 16.0<br>16.0   | 24.0<br>23.0                                                       |     | ns    |  |
| PLH                                  | Propagation Delay<br>SEL <sub>n</sub> to CAS <sub>n</sub> | 4.5<br>4.5                                                                  | 9.0<br>9.0  | 14.5<br>14.5 | 4.0<br>4.0 | 15.5<br>15.5   | 24.0<br>24.0                                                       |     | ns    |  |

\*These values are given for typical derivative with a 500 pF load; these are not guaranteed specifications.

# **AC Electrical Characteristics**

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|                  |                        |     |                                                                                                                                     | 74F |                                                      |       |    |
|------------------|------------------------|-----|-------------------------------------------------------------------------------------------------------------------------------------|-----|------------------------------------------------------|-------|----|
| Symbol           | Parameter              |     | $\begin{array}{l} \textbf{T_A}=~+~25^\circ\textbf{C}\\ \textbf{V_{CC}}=~+~5.0\textbf{V}\\ \textbf{C_L}=~50~\textbf{pF} \end{array}$ |     | T <sub>A</sub> , V <sub>CC</sub><br>C <sub>L</sub> = | Units |    |
|                  |                        | Min | Тур                                                                                                                                 | Max | Min                                                  | Max   |    |
| t <sub>PHZ</sub> | Output Disable Time    | 1.0 | 5.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  | ns |
| t <sub>PLZ</sub> | OE to Q <sub>n</sub>   | 1.0 | 4.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  |    |
| t <sub>PZH</sub> | Output Enable Time     | 1.0 | 5.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  | ns |
| t <sub>PZL</sub> | OE to Q <sub>n</sub>   | 1.0 | 6.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  |    |
| t <sub>PHZ</sub> | Output Disable Time    | 1.0 | 5.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  | ns |
| t <sub>PLZ</sub> | OE to RAS <sub>n</sub> | 1.0 | 4.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  |    |
| t <sub>PZH</sub> | Output Enable Time     | 1.0 | 5.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  | ns |
| t <sub>PZL</sub> | OE to RAS <sub>n</sub> | 1.0 | 6.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  |    |
| t <sub>PHZ</sub> | Output Disable Time    | 1.0 | 5.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  | ns |
| t <sub>PLZ</sub> | OE to CAS <sub>n</sub> | 1.0 | 4.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  |    |
| <sup>t</sup> PZH | Output Enable Time     | 1.0 | 5.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  | ns |
| t <sub>PZL</sub> | OE to CAS <sub>n</sub> | 1.0 | 6.0                                                                                                                                 | 9.5 | 1.0                                                  | 10.0  |    |

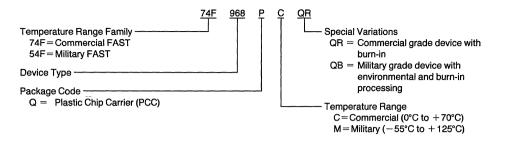
# **AC Operating Requirements**

|                                          |                                                               |              | 74F              |                                  |       |    |  |  |  |
|------------------------------------------|---------------------------------------------------------------|--------------|------------------|----------------------------------|-------|----|--|--|--|
| Symbol                                   | Parameter                                                     |              | + 25°C<br>+ 5.0V | T <sub>A</sub> , V <sub>CC</sub> | Units |    |  |  |  |
|                                          |                                                               | Min          | Max              | Min                              | Max   |    |  |  |  |
| t <sub>s</sub> (H)<br>t <sub>s</sub> (L) | Setup Time, HIGH or LOW<br>A <sub>n</sub> to LE               | 5.0<br>5.0   |                  | 5.0<br>5.0                       |       | ns |  |  |  |
| t <sub>h</sub> (H)<br>t <sub>h</sub> (L) | Hold Time, HIGH or LOW<br>A <sub>n</sub> to LE                | 5.0<br>5.0   |                  | 5.0<br>5.0                       |       | ns |  |  |  |
| t <sub>s</sub> (H)<br>t <sub>s</sub> (L) | Setup Time, HIGH or LOW<br>SEL to LE                          | 5.0<br>5.0   |                  | 5.0<br>5.0                       |       | ns |  |  |  |
| t <sub>h</sub> (H)<br>t <sub>h</sub> (L) | Hold Time, HIGH or LOW<br>SEL to LE                           | 5.0<br>5.0   |                  | 5.0<br>5.0                       |       | ns |  |  |  |
| t <sub>w</sub> (H)<br>t <sub>w</sub> (L) | Pulse Width, HIGH or LOW $\overline{CAS}_n, \overline{RAS}_n$ | 15.0<br>15.0 |                  | 15.0<br>15.0                     |       | ns |  |  |  |
| t <sub>skew</sub>                        | $Q_n$ to $\overline{CAS}_n$ , $\overline{RAS}_n$              | 10.0         |                  | 10.0                             |       | ns |  |  |  |

1

### **Ordering Information**

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



# Precautions to Take When Driving Memories

National Semiconductor Application Note 305 Mike Evans



As memory prices continue their relentless reduction of cost per bit, more and more systems designers are incorporating memories into their designs. In general these memories comprise a number of dynamic RAMs, such as the 64k x 1. In this x 1 configuration, the number of RAMs required is a multiple of the bus width. Most new system designs use 16bit microprocessors, so that a typical memory will comprise from 16 to 64 DRAMs, thus providing from 64k to 256k addressing capability. This means the memory drivers have to drive upwards of 16 RAMs. The drivers may be part of an integrated circuit dynamic RAM controller such as the DP8408A/DP8409A, or they may be on a separate chip such as the DP84240/DP84244 octal memory drivers. The recommendations in this article are valid for any type of memory driver. The purpose of the article is to forewarn new designers using memories of problems they will encounter if adequate precautions are not taken.

A typical configuration of a 16-bit wide memory is shown in *Figure 1*. Each driver address output goes to every dynamic RAM, as does  $\overline{WE}$ .  $\overline{CAS}$  outputs go to half the number of RAMs assuming byte writing is required.  $\overline{RAS}$  outputs each go only to one bank. Note that these loads are not true for the data inputs and outputs. Each data I/O only connects to its respective bit, so the loading is only one RAM per bank for data. In general, this is why buffers are not required on the data bus when interfacing to memory. Data In of the RAMs can be linked directly to Data Out for any one bit, and also to the corresponding bit on the data bus. This is true for normal read and write operations, but if read-modify-write cycles are employed, the Data Out signals must be buffered from the data bus.

Using this typical memory configuration may not be as simple as it seems. Without care and attention, problems can arise for the unprepared, and there are two areas in particular which may cause memory errors or memory damage: one is voltage overshoot caused by inductive traces and high capacitive loads, the other is switching spikes caused by switching high capacitive loads.

### OVERSHOOT AND UNDERSHOOT

(Undershoot is Negative Overshoot)

When a system requires a number of dynamic RAMs, the result is high capacitance loads, caused by a combination of RAM input capacitance and trace capacitance. Each dynamic RAM has a specified input capacitance of 10 pF maximum, but most dynamic RAMs are closer to 2 to 3 pF. Very few actually get close to 10 pF, even under worst case conditions of high temperature and V<sub>CC</sub>. It is safe, therefore, to assume a much lower average input capacitance when using 16 or more RAMs.

In fact, the input capacitance of most inputs is due more to the package than the input gating, because the silicon gate inputs of the transistors in today's market have such high impedance. A typical maximum would be 2.5 pF. Control inputs such as  $\overline{RAS}$  and  $\overline{CAS}$  connect to more than one transistor input. For example, on the National Semiconductor 64k x 1 dynamic RAM, the NMC4164,  $\overline{RAS}$  goes to two transistors and  $\overline{CAS}$  to four. In general, this is true for most

manufacturers' RAMs, so a more typical maximum input capacitance would be 3 pF for  $\overline{RAS}$  and 3.5 pF for  $\overline{CAS}$ . RAM input currents are so small as to be negligible. The input current is quoted as 10  $\mu A$  maximum, but again most RAMs are much less than this in a typical memory. Driving DRAMs, therefore, is not a problem of DC drive capability, but rather a problem of capacitance drive capability.

Driving DRAM input capacitance is further compounded by printed circuit traces, and even more so by wire-wrapping. Both can be represented by a transmission line with distributed capacitance and inductance. Thus, the total load is equivalent to a complex impedance comprising the distributed trace inductance, and a capacitance comprising distributed trace capacitance and RAM input capacitance as shown in *Figure 2a*.

The effect is an overshoot or undershoot at the dynamic RAM inputs that occurs each time a memory driver changes state, as shown in Figure 2b. As the driver output changes state, the load capacitance cannot be instantaneously charged or discharged because the current available is limited both by the driver transistor impedance, and the equivalent series resistance from the supply rail through the chip to the trace resistance. This current will be similar in value to the quoted short circuit current of the driver stage; therefore there is a spike of current that lasts as long as it takes to change the voltage of all the capacitances. For the driver stages of the DP8408A/DP8409A, or the DP84240/ DP84244, the typical short circuit current is 100 mA per stage. This is true for either direction, so that the high-to-low transition takes roughly the same time as the low-to-high transition, minimizing skew times on all the driver outputs, as they transition in either direction. Assuming the output low voltage, V<sub>OL</sub>, is 0.2V and the output high voltage, V<sub>OH</sub>, is 3.2V, and that the charge/discharge current is constant at ISC, then the current spike will exist for a time, T, where,

$$T = C_{IL} \times (V_{OH} - V_{OL})/I_{SC}$$
  
= 500 pF × 3.0V/100 mA = 15

 $C_{\rm L}$  (500 pF) is the load capacitance of typically 64 to 88 dynamic RAMs, in other words, four banks comprising 16 data bits and possibly six check bits if error correction is required.

ns

In fact, due to the trace inductance, the rate of change of current will not be a step function, so that the current waveform looks like a spike. Even so, the rapid rate of change of current, di/dt, into the trace inductance L, will create a potentially excessive voltage "e" across this inductance. As an example, if the current changes from 0 to 100 mA in 6 ns, and the composite trace inductance is  $0.3 \ \mu$ H, then the voltage across this inductance is "e,"where,

= 0.3  $\mu$ H imes 100 mA/6 ns = 5V

In other words, at this rate of change in current, even a small inductance can be dangerous for two reasons. First, the dynamic RAMs at the far end of the trace could be destroyed, unless they have clamping diodes to  $V_{CC}$  and GND (most do not), or second, the returning voltage may exceed the threshold it has just passed causing a second

and then third change of state. If this sudden glitch occurs on a control signal input such as RAS, the memory contents may be inadvertently changed.

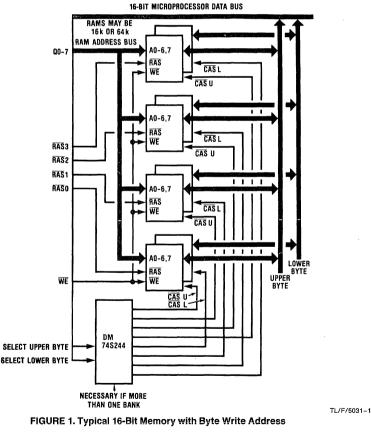
It is therefore necessary to remove the spike. The most common approach is to insert a damping resistor in the path between the driver and the RAMs, fairly close to the driver, as shown by R<sub>D</sub> in Figure 2a. The best value for the resistor is the critical value giving a critically damped transition. Too high a value will cause overdamping which results in a slow transition. This slow edge may create excessive skew problems and slow down the memory cycle, or even worse, the edge may be slow enough that the RAM cycle never begins internally. If the damping resistor value is too low, the undershoot or overshoot may not be removed. It is therefore recommended that the resistor be determined on the first prototypes (not wire-wrapped prototypes because the value will be different due to the larger distributed inductance and capacitance). Also, the values may be different for the control lines, particularly CAS. If there are a number of banks, and a RAS is used to select each bank, then the damping resistor in this line will be higher.

Typical values for the damping resistors will be between 15 $\Omega$  and 100 $\Omega$ , the lower the loading, the higher the values.

Some IC manufacturers offer octal memory drivers with onchip series resistors fixed at  $\approx 25\Omega$ . Unless this is the critical value required for all the lines, problems will arise. The DP8400 family has been designed with equivalent internal values of approximately  $10\Omega$ , allowing for any external value of damping resistor.

### SWITCHING CURRENT SPIKES

Another major undesirable effect of the fast current spikes is the effect on the  $V_{CC}$  and GND pins. The worst case is when all eight or nine address outputs switch in the same direction at the same time, as shown in Figure 3a. If each driver can source or sink 100 mA, then a current of approximately 1A could enter or exit the driver chip in a period of 20 ns. The resistance and inductance of the  $V_{\mbox{CC}}$  and  $\mbox{GND}$ lines to the chip can cause excessive drops during this switching time (see waveforms in Figure 3a), which may, in turn, upset latches either in the DP8408A/DP8409A, or externally. A ceramic capacitor connected across V<sub>CC</sub> and GND pins will largely remove the spike. A 1 µF multilayer ceramic is recommended. This should be fitted as close as possible to the pins in order to reduce lead inductance. The DP8408A/DP8409A pin configuration facilitates this with



TRACE INDUCTANCE ΰC CINI  $C = \Sigma(CS + CIN), L = \Sigma L$ r = 10Ω FOR DP8408A/09A or DP84240/244 TL/E/5031-2 FIGURE 2a. Complex Load Impedance Caused by Distributed Trace Inductance L and Capacitance C<sub>S</sub>, and RAM Input Capacitance CIN IF RETURNING OSCILLATOR IS TOO HIGH, A GLITCH MAY OCCUR FAST EDGE WITH NO OVERSHOOT EDGE TOO SLOW

FIGURE 2b. Timing Waveforms Showing the Effect of Variations of R<sub>D</sub> on Signals Appearing at the RAM

GND and V<sub>CC</sub> pins 0.2" apart so that the ceramic capacitor can be fitted as close to the chip as possible. The second GND pin should also be decoupled. These GND and V<sub>CC</sub> pins are located in the center of the package to reduce bonding lead lengths. In fact, the lead resistance is five times lower than if the supply pins were in the corners. An example of how this spike can be reduced would be the previous example of a 1A change in supply current switching in 20 ns with a 1 µF ceramic capacitor decoupling GND and V<sub>CC</sub>. The voltage drop "v" is 1A×20 ns/1  $\mu$ F, or 20 mV.

VCC

٥v

DRIVER

٥c

ΰC

n١

CURRENT i

NO RD OR RD TOO LOW

ΰC CRITICALLY DAMPED Rn

OVERDAMPED RD (RD TOO HIGH)

ODRIVER

Rn

If the decoupling capacitor was 0.01 µF, the drop would be 2V. Tantalum or other types of capacitors are lower frequency capacitors and have only a small effect in reducing the voltage spike. Ceramic capacitors are high frequency, and multilayer capacitors with lower inductance have a greater effect in reducing the voltage spike and are therefore recommended. As a further recommendation, the dynamic RAMs should be similarly decoupled with approximately a 0.1 µF ceramic capacitor on each RAM. Wire-wrapped boards, in particular, need special attention.

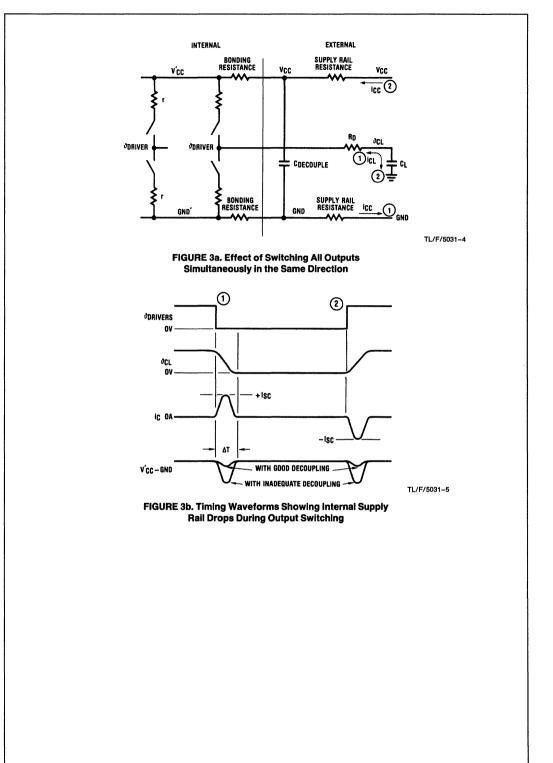
TL/F/5031-3

There are some other precautions that may be considered when driving memories. First, be aware that IC sockets increase load capacitance and inductance, so it becomes a matter of the importance of removability of chips, and maintainability. Also, shorter, thicker trace lengths will reduce the load, and good GND and  $V_{CC}$  connections will help reduce the voltage spikes around the memory board. For wirewrapped designs, GND and V<sub>CC</sub> should be multiwired.

With proper decoupling and correct selection of damping resistors, integrated circuit dynamic RAM controllers will function as expected to ease the burden of the system designer.

AN-305

**AN-305** 



# DP8408A/09A/17/18/19/ 28/29 Application Hints

The DP8408A, DP8409A dynamic RAM controllers have been well received by dynamic memory users because they perform functions formerly requiring multiple integrated circuit chips. These controllers are designed to be suitable for a variety of DRAM control methods. As a result of the many combinations of ways in which inputs to these chips may be varied, it was inevitable that certain conditions exist that would cause the DP8408A, DP8409A to respond in an undesirable way. Feedback from customers using these chips has resulted in thorough investigations of such conditions. The following are constraints on the use of the DRAM controllers which are not addressed in their data sheets. The majority of customers will find that most of the items on this list are not pertinent to their particular application, and those that are impose minimal restrictions.

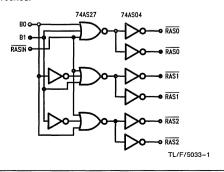
- The on-chip refresh counter resets when the RFI/O pin goes low for a refresh request in mode 5 if this pin is excessively loaded with capacitance. The data sheet suggests that this pin not be loaded with greater than 50 pF. Since RFI/O, in most cases, needs only to drive a low capacitance in a refresh control circuit, this limit is not unreasonable.
- 2) When the DP8408A, DP8409A is in a refresh mode, the RFI/O pin indicates that the on-chip refresh counter has reached its end-of-count. This end-of-count is selectable as 127, 255 or 511 (511 is available only on the DP8409A) to accommodate 16k, 64k or 256k DRAMS, respectively. Although the end-of-count may be chosen to be any of these, the counter always counts to 511 (255 for the DP8408A) before rolling over to zero.
- 3) When going from mode 0, 1 or 2 (refresh) to mode 5 of the DP8408A, if <u>CASIN</u> and R/C are both low, a glitch occurs on the <u>CAS</u> output. Since neither of these inputs is used in these modes, one or both should be held high.
- 4) Most DRAMs specify 0 ns row address set-up time to RAS. In order to guarantee this, the row address to the DP8408A, DP8409A must be valid 10 ns before RASIN transitions low to initiate an access. In terms of the data sheet parameters, maximum (t<sub>APD</sub>-t<sub>RPDL</sub>) = 10 ns.
- 5) When changing modes from refresh to access, again sufficient time must be allowed for the row address to be valid before RAS occurs. In this case, the address outputs of the DP8409A, DP8409A are changing from the refresh counter to the row address inputs. In order for the row address to be set up a minimum of 0 ns before RAS goes low, RASIN should not go low until 30 ns after the change from refresh to access mode.
- 6) Both the low and high pulse widths of RAS have minimum requirements during refresh. When in mode 0, the RASIN to RAS low delay is longer than the RASIN to RAS high delay. In terms of the data sheet parameters, maximum (t<sub>RFPDL</sub>-t<sub>RFPDH</sub>) = 25 ns. Thus, the minimum low pulse width of RAS in mode 0 equals the RASIN low pulse width minus 25 ns. The minimum high pulse width of RAS in mode 0 equals the RASIN high pulse width.
- 7) The fastest memory access may be accomplished using mode 4 and external delay lines (see App. Brief #9).

National Semiconductor Application Brief #1 Tim Garverick Webster Meier



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- 8) In the data sheet, it is specified that CS should go low 30 ns (t<sub>CSLR</sub>) before RASIN goes low to initiate an access in mode 5. This is to prevent the possibility of a glitch on the RAS outputs, resulting from the DP8409A interpreting the RASIN as a hidden refresh. For the same reason, CS should be held low for a minimum of 15 ns after RASIN returns high, ending the access in mode 5.
- 9) If the DP8409A is being used in mode 5 and  $\overline{CS} = 1$ , and if  $\overline{RASIN}$  goes low within 15 ns before RFCK (R/ $\overline{C}$ ) goes low, up to a 15 ns glitch may occur on the refresh request pin, RFI/O. However, since  $\overline{CS}$  is high, a hidden refresh will occur as it normally would with RFCK high. If the glitch on RFI/O were detected and interpreted as a forced refresh request, no forced refresh would be allowed by the DP8409A since a hidden refresh was allowed. This would not cause any problem, however, since the hidden refresh has taken care of the refresh requirement for that period of RFCK. Also, this forced refresh request could not be detected if the system does not check RFI/O for a low state while  $\overline{RASIN}$  is low (i.e., an access is taking place).
- 10) At CPU clock frequencies of 10 MHz and above it is suggested that the hidden refresh capability of the DRAM controller (DP8409/17/19/29) be disabled. The main reason for this suggestion is to satisfy the parameter "tRKRL" (RFCK high to RASIN low for hidden refresh) which is given as a minimum of 50 ns in the DP8417/19/29 data sheets. Disabling hidden refresh also eliminates the need of meeting the parameter of "t<sub>CSBL1</sub>" (CS low to access RASIN low using Mode 5 with hidden refresh capability) which is given as a minimum of 34 ns in the DP8417/19/29 data sheets. In order to eliminate hidden refresh the "CS" pin of the DRAM controller should be permanently grounded on the DRAM controller, and the "CS" that previously went to the DRAM controller should be "ORed" with "RASIN" (the "OR" gate's output becoming the new "RASIN" input to the DRAM controller).
- 11) If the user desires to improve the DRAM controller "RASIN to RAS out" time ("tRPDL") external logic may be used to create multiple "RASs". The circuit shown below requires only several 74XX oxide isolated type IC's (74AS27 and 74AS04) to accomplish this aim. To use this circuit RASIN should transition low during refreshes.



# **AB-9**

# DP8408A/9A Fastest DRAM Access Mode

If one desires the fastest possible operation of the DP8408A/9A multi-mode dynamic RAM controller/driver in accessing DRAMs, mode 4, externally controlled access mode should be considered.

In using mode 4 there are three input signals which must be considered:

- 1) RASIN—generates RAS
- R/C
  —switches between rows and columns on the address outputs
- 3) CASIN—generates CAS

In producing these signals a delay will be needed between RASIN and R/ $\overline{C}$  and between R/ $\overline{C}$  and  $\overline{CASIN}$ . (Note: In mode 4 external generation of  $\overline{CASIN}$  can produce  $\overline{CAS}$  faster than automatic generation of  $\overline{CAS}$ .)

Two important parameters have been added to the DP8408A/9A data sheets that help one compute the minimum acceptable delays between the above-mentioned signals. These parameters are:

1)  $t_{DIF1} = MAXIMUM (t_{RPDL} - t_{RHA}) = 13 \text{ ns}$ where  $t_{RPDL} = \overline{RASIN}$  to  $\overline{RAS}$  delay

t<sub>RHA</sub> = row address held from column select

2)  $t_{DIF2} = MAXIMUM (t_{RCC} - t_{CPDL}) = 13 \text{ ns}$ 

where  $t_{\text{RCC}}$  = column select to column address valid

$$t_{CPDL} = \overline{CASIN}$$
 to  $\overline{CAS}$  delay

These parameters are specified as being less than what would be calculated using the min/max values given for  $t_{RCC}, t_{CPDL}, t_{RPDL}$  and  $t_{RHA}$  in the DP8408A/9A specification sheets, because on-chip delays track over temperature and supply variations.

The equation for the delay between  $\overline{\text{RASIN}}$  and R/C that guarantees the specified DRAM  $t_{\text{RAH}}$  is:

min delay required =  $t_{DIF1} + t_{RAH}$ 

= 13 ns + t<sub>RAH</sub>

where 
$$t_{RAH} = DRAM$$
 minimum row address  
hold time from  $\overline{RAS}$ 

National Semiconductor Application Brief Tim Garverick Rusty Meier



The equation for the delay between R/C and  $\overline{CASIN}$  that guarantees the specified DRAM t<sub>ASC</sub> is:

min delay required =  $t_{DIF2} + t_{ASC}$ 

 $= 13 \text{ ns} + t_{ASC}$ 

# where $t_{ASC} = DRAM$ minimum column address set-up time to $\overline{CAS}$

To produce the above-mentioned delays between signals, a  $\pm 2$  ns resolution delay line can be used as follows:

(assuming 
$$t_{RAH} = 20$$
 ns,  $t_{ASC} = 0$  ns  
 $\overline{RASIN}$  to  $R/\overline{C}$  delay = 13 ns + 20 ns

IN to R/C delay = 
$$13 \text{ ns} + 20 \text{ ns}$$

 $R/\overline{C}$  to  $\overline{CASIN}$  delay = 13 ns + 0 ns

= 13 ns

Thus, R/C must follow  $\overrightarrow{\text{RASIN}}$  by a minimum of 33 ns and  $\overrightarrow{\text{CASIN}}$  must follow R/C by a minimum of 13 ns. With a delay line of  $\pm$  2 ns resolution, the  $\overrightarrow{\text{RASIN}}$  to R/C and R/C to  $\overrightarrow{\text{CASIN}}$  delays can be typicals of 35 ns and 15 ns, respectively. (See *Figures 1* and 2.)

This scheme will provide a maximum  $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  delay of:

35 ns + 15 ns + 2 ns (resolution uncertainty)

+ MAXIMUM ( $t_{CPDL}$ ) = 52 ns + MAXIMUM ( $t_{CPDL}$ )

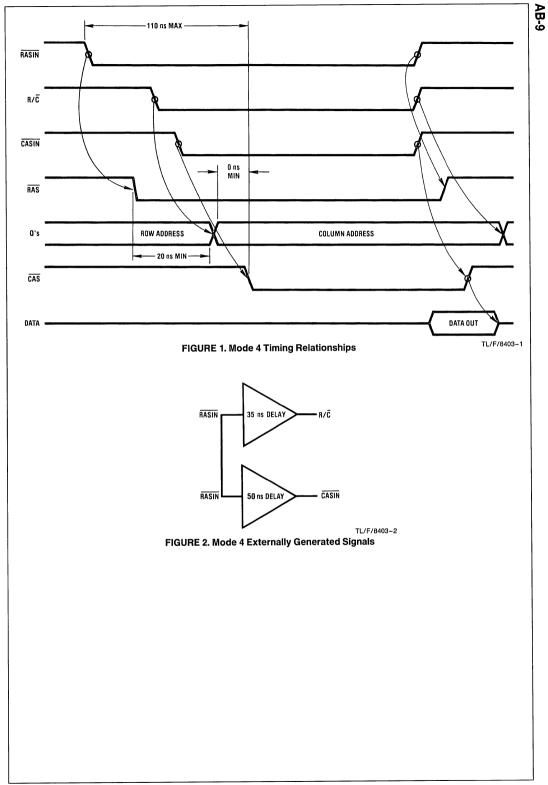
For the DP8408/9-2, MAXIMUM ( $t_{CPDL}$ ) = 58 ns.

For the DP8408A/9A (no dash), MAXIMUM ( $t_{CPDL}$ ) = 68 ns (not 58 ns as indicated in data sheets up to November 1982).

The fastest mode 4 accesses (with the assumed delay line and DRAM parameters) are therefore, 110 ns and 120 ns, respectively, for the -2 and non-dash parts.

The maximum  $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  delay (t<sub>RICL</sub>) in mode 5 (auto mode) for the DP8408/9-2 (which guarantees a min t<sub>RAH</sub> of 20 ns) is 130 ns. The maximum t<sub>RICL</sub> in mode 5 for the DP8408A/9A (no dash) is 160 ns.

Thus, it is shown that if the features offered by the DP8408A/9A automatic modes can be sacrificed, mode 4 (externally controlled access) may be used to obtain the fastest memory access.



ALC: NO



# Section 2 Error Detection and Correction

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# **Section 2 Contents**

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# 54F/74F420 Parallel Check Bit/Syndrome Bit Generator

### **General Description**

The 'F420 is a parallel check bit/syndrome bit generator. The 'F420 utilizes a modified hamming code to generate 7 check bits from a 32-bit dataword, in 15 ns, when operated in the check bit generate mode. When operated in the syndrome generate mode, the check bits and data bits

read from memory are utilized in a parity summer to generate syndrome bits upon error detection. The maximum error count detectable is 2. A single error detect can occur in 18 ns; a double error detect in 22 ns. The syndrome bit generation can be output in 15 ns (maximum).

# Logic Diagram

### **Connection Diagrams** Pin Assignment **Pin Assignment** for LCC and PCC for DIP and Flatpak Dz. D<sub>8</sub> D<sub>7</sub> D<sub>6</sub> D<sub>5</sub> D<sub>4</sub> GND NCV<sub>CC</sub> D<sub>3</sub> D<sub>2</sub> D<sub>1</sub> D<sub>0</sub> C<sub>6</sub> 20 19 18 17 16 15 14 13 12 11 10 19 18 SEF c<sub>o</sub> 48 ۰s٥ $\overline{}$ c<sub>1</sub>. DEF 47 • S<sub>1</sub> D<sub>9</sub> 27 2 C2 46 - SEE D11 D2 D3 D4 D3 D4 D3 D4 D5 D4 D5 D6 D7 D6 D7 D6 D7 D6 D7 D7 D6 D7 <thD7</th> D7 D7 D7< c3-DEF С<sub>5</sub> 45 C₄ C. C4 44 - CB с<sub>5</sub>-• NC 42 -D<sub>31</sub> TL/F/9542-1 C<sub>6</sub> Do 41 -D<sub>30</sub> D<sub>1</sub> 40 -D<sub>29</sub> 39 -D<sub>28</sub> D2 10 D3 11 38 -D<sub>27</sub> 37 -D<sub>26</sub> 12 Vcc налананала GND 13 36 - GND 34 35 36 37 38 39 40 41 42 43 44 45 46 35 -D<sub>25</sub> D4 14 D<sub>21</sub> D<sub>22</sub> D<sub>23</sub> D<sub>24</sub> D<sub>25</sub> GND NC D<sub>26</sub> D<sub>27</sub> D<sub>28</sub> D<sub>29</sub> D<sub>30</sub> D<sub>31</sub> 15 34 -D<sub>24</sub> D<sub>5</sub> TL/F/9542-2 33 -D<sub>23</sub> 16 D<sub>6</sub> 17 32 -D<sub>22</sub> D7 31 D<sub>21</sub> 18 D<sub>8</sub> -D<sub>20</sub> 19 30 Dg 29 D<sub>19</sub> 20 D<sub>10</sub> • D<sub>11</sub> -21 28 -D<sub>18</sub> 22 27 D<sub>12</sub> -D<sub>17</sub> -D<sub>16</sub> D<sub>13</sub>-23 26 25 D<sub>14</sub> 24 -D<sub>15</sub>

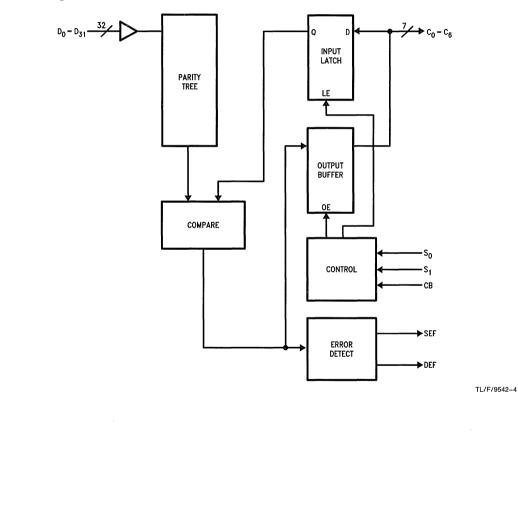
TL/F/9542-3

### **Unit Loading/Fan Out**

|                                 |                                | 54F/74F       |                                                                                   |  |  |  |
|---------------------------------|--------------------------------|---------------|-----------------------------------------------------------------------------------|--|--|--|
| Pin Names                       | Pin Names Description          |               | Input I <sub>IH</sub> /I <sub>IL</sub><br>Output I <sub>OH</sub> /I <sub>OL</sub> |  |  |  |
| C0-C6                           | Check Bit/Syndrome Bus Inputs/ | 3.5/1.083     | 70 μA/−0.65 mA                                                                    |  |  |  |
|                                 | Outputs                        | 150/40 (33.3) | -3 mA/24 mA (20 mA)                                                               |  |  |  |
| D <sub>0</sub> -D <sub>31</sub> | Data Bit Bus                   | 1.0/1.0       | 20 µA/ − 0.6 mA                                                                   |  |  |  |
| СВ                              | Check Bit Control              | 1.0/1.0       | 20 µA/−0.6 mA                                                                     |  |  |  |
| DEF                             | Double Error Flag              | 50/33.3       | -1 mA/20 mA                                                                       |  |  |  |
| SEF                             | Single Error Flag              | 50/33.3       | -1 mA/20 mA                                                                       |  |  |  |
| S <sub>0</sub> , S <sub>1</sub> | Mode Control                   | 1.0/1.0       | 20 µA/ − 0.6 mA                                                                   |  |  |  |

| Function Table  |                      |   |           |                      |                       |     |      |
|-----------------|----------------------|---|-----------|----------------------|-----------------------|-----|------|
| Memory<br>Cycle | Function Ch          |   | Check Bit | CB Control<br>I/O    | Error Flags<br>SEF DE |     |      |
| Write           | Generate Check Bits  | L | L         | Output Check         | L                     | н   | н    |
| Read            | Read & Flag          | н | L         | Input                | н                     | Ena | bled |
| Read            | Latch Check Bits     | н | н         | Inputs               | н                     | Ena | bled |
| Read            | Output Syndrome Bits | н | н         | Output Syndrome Bits | L                     | Ena | bled |
| Diagnostics     | Input Diagnostic     | н | н         | Latched Check        | н                     | Ena | bled |
|                 | Data Word            |   |           | Outputs High-Z       |                       |     |      |
| Diagnostics     | Input Diagnostic     | L | н         | Output Latched       | L                     | Ena | bled |
|                 | Data Word            |   |           | Check Bits           |                       |     |      |
| Diagnostics     | Input Diagnostic     | н | н         | Output Syndrome      | out Syndrome L En     |     | bled |
|                 | Data Word            |   |           | Bits                 |                       |     |      |

# **Block Diagram**



### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| Storage Temperature                 | -65°C to +150°C                      |
|-------------------------------------|--------------------------------------|
| Ambient Temperature under Bias      | -55°C to +125°C                      |
| Junction Temperature under Bias     | -55°C to +175°C                      |
| V <sub>CC</sub> Pin Potential to    |                                      |
| Ground Pin                          | -0.5V to +7.0V                       |
| Input Voltage (Note 2)              | -0.5V to +7.0V                       |
| Input Current (Note 2)              | -30 mA to +5.0 mA                    |
| Voltage Applied to Output           |                                      |
| in HIGH State (with $V_{CC} = 0V$ ) |                                      |
| Standard Output                     | -0.5V to V <sub>CC</sub>             |
| TRI-STATE <sup>®</sup> Output       | -0.5V to $+5.5V$                     |
| Current Applied to Output           |                                      |
| in LOW State (Max)                  | twice the rated I <sub>OL</sub> (mA) |

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

### **DC Electrical Characteristics**

# Recommended Operating Conditions

| Free Air Ambient Temperature |                 |
|------------------------------|-----------------|
| Military                     | -55°C to +125°C |
| Commercial                   | 0°C to +70°C    |
| Supply Voltage               |                 |
| Military                     | +4.5V to +5.5V  |
| Commercial                   | +4.5V to +5.5V  |

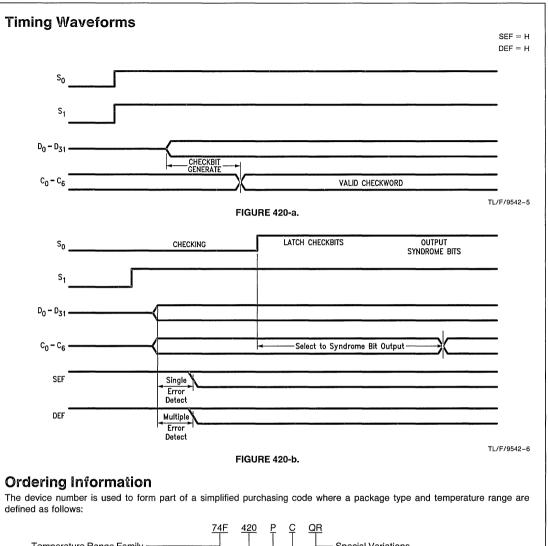
| Symbol                 | Parameter                                 |                                                                                                                                                              |                                        | 54F/74 | =                 | Units | vcc  | Conditions                                                                                                                                                                                                                                                                  |  |
|------------------------|-------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------|--------|-------------------|-------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Symbol                 | Falalle                                   | i di dificici                                                                                                                                                |                                        | Тур    | Max               | Units | vcc  |                                                                                                                                                                                                                                                                             |  |
| VIH                    | Input HIGH Voltage                        |                                                                                                                                                              | 2.0                                    |        |                   | V     |      | Recognized as a HIGH Signa                                                                                                                                                                                                                                                  |  |
| V <sub>IL</sub>        | Input LOW Voltage                         |                                                                                                                                                              |                                        |        | 0.8               | V     |      | Recognized as a LOW Signal                                                                                                                                                                                                                                                  |  |
| V <sub>CD</sub>        | Input Clamp Diode                         | /oltage                                                                                                                                                      |                                        |        | -1.2              | V     | Min  | $I_{IN} = -18 \text{ mA}, D_n, CB, S_0, S$                                                                                                                                                                                                                                  |  |
| V <sub>OH</sub>        | Output HIGH<br>Voltage                    | 54F 10% V <sub>CC</sub><br>54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 5% V <sub>CC</sub><br>74F 5% V <sub>CC</sub> | 2.5<br>2.4<br>2.5<br>2.4<br>2.7<br>2.7 |        |                   | v     | Min  | $\begin{array}{l} l_{OH}=-1 \text{ mA} \text{ (All Outputs)} \\ l_{OH}=-3 \text{ mA} (C_0-C_6) \\ l_{OH}=-1 \text{ mA} \text{ (All Outputs)} \\ l_{OH}=-3 \text{ mA} (C_0-C_6) \\ l_{OH}=-1 \text{ mA} \text{ (All Outputs)} \\ l_{OH}=-3 \text{ mA} (C_0-C_6) \end{array}$ |  |
| V <sub>OL</sub>        | Output LOW<br>Voltage                     | 54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub>                                                                                |                                        |        | 0.5<br>0.5<br>0.5 | v     | Min  | $I_{OL} = 20 \text{ mA} \text{ (All Outputs)}$<br>$I_{OL} = 20 \text{ mA} \text{ (DEF, SEF)}$<br>$I_{OL} = 24 \text{ mA} \text{ (C}_0 - \text{C}_6)$                                                                                                                        |  |
| ΙΉ                     | Input HIGH<br>Current                     | 54F<br>74F                                                                                                                                                   |                                        |        | 20.0<br>5.0       | μΑ    | Max  | V <sub>IN</sub> = 2.7V                                                                                                                                                                                                                                                      |  |
| I <sub>BVI</sub>       | Input HIGH Current<br>Breakdown Test      | 54F<br>74F                                                                                                                                                   |                                        |        | 100<br>7.0        | μA    | Max  | V <sub>IN</sub> = 7.0V                                                                                                                                                                                                                                                      |  |
| ICEX                   | Output HIGH<br>Leakage Current            | 54F<br>74F                                                                                                                                                   |                                        |        | 250<br>50         | μA    | Max  | $V_{OUT} = V_{CC}$                                                                                                                                                                                                                                                          |  |
| V <sub>ID</sub>        | Input Leakage<br>Test                     | 74F                                                                                                                                                          | 4.75                                   |        |                   | v     | 0.0  | $I_{ID} = 1.9 \ \mu A$<br>All Other Pins Grounded                                                                                                                                                                                                                           |  |
| IOD                    | Output Leakage<br>Circuit Current         | 74F                                                                                                                                                          |                                        |        | 3.75              | μA    | 0.0  | V <sub>IOD</sub> = 1.50 mV<br>All Other Pins Grounded                                                                                                                                                                                                                       |  |
| IBVIT                  | Input HIGH Current<br>Breakdown Test (1/0 | D)                                                                                                                                                           |                                        |        | 1.0               | mA    | Max  | $V_{IN} = 5.5V (C_0 - C_6)$                                                                                                                                                                                                                                                 |  |
| l <sub>IL</sub>        | Input LOW Current                         |                                                                                                                                                              |                                        |        | -0.6              | mA    | Max  | $V_{IN} = 0.5V (D_n, CB, S_0, S_1)$                                                                                                                                                                                                                                         |  |
| I <sub>IH</sub> + Iozн | Output Leakage Cur                        | rent                                                                                                                                                         |                                        |        | 70                | μΑ    | Max  | $V_{OUT} = 2.7V (C_0 - C_6)$                                                                                                                                                                                                                                                |  |
| IIL + IOZL             | Output Leakage Cur                        | rent                                                                                                                                                         |                                        |        | -650              | μΑ    | Max  | $V_{OUT} = 0.5V (C_0 - C_6)$                                                                                                                                                                                                                                                |  |
| los                    | Output Short-Circuit                      | Current                                                                                                                                                      | -60                                    |        | -150              | mA    | Max  | $V_{OUT} = 0V$                                                                                                                                                                                                                                                              |  |
| I <sub>ZZ</sub>        | Bus Drainage Test                         |                                                                                                                                                              |                                        |        | 500               | μΑ    | 0.0V | $V_{OUT} = 5.25V$                                                                                                                                                                                                                                                           |  |
| Іссн                   | Power Supply Curre                        | nt                                                                                                                                                           |                                        |        | 130               | mA    | Max  | V <sub>O</sub> = HIGH                                                                                                                                                                                                                                                       |  |
| ICCL                   | Power Supply Curre                        | nt                                                                                                                                                           |                                        |        | 130               | mA    | Max  | $V_0 = LOW$                                                                                                                                                                                                                                                                 |  |
| lccz                   | Power Supply Curre                        | nt                                                                                                                                                           |                                        |        | 130               | mA    | Max  | V <sub>O</sub> = HIGH Z                                                                                                                                                                                                                                                     |  |

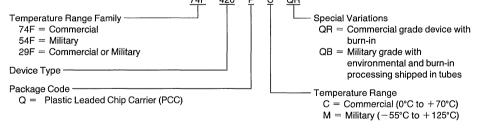
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|                                      |                                                            |            | 74F                                                              |              | 5   | 4F               | 7                                                    | Units        |    |
|--------------------------------------|------------------------------------------------------------|------------|------------------------------------------------------------------|--------------|-----|------------------|------------------------------------------------------|--------------|----|
| Symbol                               | Parameter                                                  | Ň          | $T_A = +25^{\circ}0$<br>$I_{CC} = +5.0$<br>$C_L = 50  \text{pF}$ | v            |     | c = Mil<br>50 pF | T <sub>A</sub> , V <sub>CC</sub><br>C <sub>L</sub> = |              |    |
|                                      |                                                            | Min        | Тур                                                              | Max          | Min | Max              | Min                                                  | Мах          |    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>D <sub>n</sub> to C <sub>n</sub>      | 5.0<br>5.0 |                                                                  | 20.0<br>17.0 |     |                  | 5.0<br>5.0                                           | 22.0<br>19.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>D <sub>n</sub> /C <sub>n</sub> to SEF | 5.0<br>4.0 |                                                                  | 20.0<br>16.0 |     |                  | 5.0<br>4.0                                           | 22.0<br>18.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay $D_n/C_n$ to DEF                         | 6.0<br>5.0 |                                                                  | 24.0<br>21.0 |     |                  | 6.0<br>5.0                                           | 26.0<br>22.0 | ns |
| t <sub>PLH</sub>                     | Propagation Delay<br>S1 to C <sub>n</sub>                  | 4.0<br>3.0 |                                                                  | 18.0<br>13.0 |     |                  | 4.0<br>3.0                                           | 19.0<br>14.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>S1 to SEF/DEF                         | 4.0<br>3.0 |                                                                  | 14.0<br>9.0  |     |                  | 4.0<br>3.0                                           | 15.0<br>10.0 | ns |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Output Enable Time                                         | 2.0<br>2.0 |                                                                  | 12.0<br>11.0 |     |                  | 2.0<br>2.0                                           | 13.0<br>12.0 |    |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time                                        | 1.0        |                                                                  | 7.5<br>7.5   |     |                  | 1.0<br>1.0                                           | 8.0<br>8.0   | ns |

# AC Operating Requirements

|                                          |                                        | 7                                     | 4F               | 54                               | F       | 7                                | 4F    |    |  |
|------------------------------------------|----------------------------------------|---------------------------------------|------------------|----------------------------------|---------|----------------------------------|-------|----|--|
| Symbol                                   | Parameter                              | T <sub>A</sub> =<br>V <sub>CC</sub> = | + 25°C<br>+ 5.0V | T <sub>A</sub> , V <sub>CC</sub> | ; = Mil | T <sub>A</sub> , V <sub>CC</sub> | Units |    |  |
|                                          |                                        | Min                                   | Max              | Min                              | Max     | Min                              | Max   | 1  |  |
| t <sub>s</sub> (H)<br>t <sub>s</sub> (L) | Setup Time, HIGH or LOW $C_n$ to $S_0$ | 5.0<br>5.0                            |                  |                                  |         | 5.0<br>5.0                       |       | ns |  |
| t <sub>h</sub> (H)<br>t <sub>h</sub> (L) | Hold Time, HIGH or LOW $C_n$ to $S_0$  | 5.0<br>5.0                            |                  |                                  |         | 5.0<br>5.0                       |       | ns |  |
| t <sub>w</sub> (L)                       | Clock Pulse Width LOW                  | 8.0                                   |                  |                                  |         | 8.0                              |       | ns |  |





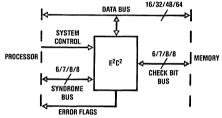




# DP8400-2-E<sup>2</sup>C<sup>2</sup> Expandable Error Checker/Corrector

### **General Description**

The DP8400-2 Expandable Error Checker and Corrector (E<sup>2</sup>C<sup>2</sup>) aids system reliability and integrity by detecting errors in memory data and correcting single or double-bit errors. The E<sup>2</sup>C<sup>2</sup> data I/O port sits across the processormemory data bus as shown, and the check bit I/O port connects to the memory check bits. Error flags are provided, and a syndrome I/O port is available. Fabricated using high speed Schottky technology in a 48-pin dual-in-line package, the DP8400-2 has been designed such that its internal delay times are minimal, maintaining maximum memory performance.



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TL/F/6899-1
```

For a 16-bit word, the DP8400-2 monitors data between the processor and memory, with its 16-bit bidirectional data bus connected to the memory data bus. The DP8400-2 uses an encoding matrix to generate 6 check bits from the 16 bits of data. In a WRITE cycle, the data word and the corresponding check bits are written into memory. When the same location of memory is subsequently read, the  $E^{2}C^{2}$  generates 6 new check bits from the memory data and compares them with the 6 check bits read from memory to create 6 syndrome bits. If there is a difference (causing some syndrome bits to go high), then that memory location contains an error and the DP8400-2 indicates the type of error with 3 error flags. If the error is a single data-bit error, the DP8400-2 will automatically correct it.

The DP8400-2 is easily expandable to other data configurations. For a 32-bit data bus with 7 check bits, two DP8400-2s can be used in cascade with no other ICs. Three DP8400-2s can be used for 48 bits, and four DP8400-2s for 64 data bits, both with 8 check bits. In all these configurations, single and double-error detection and single-error correction are easy to implement.

When the memory is more unreliable, or better system integrity is preferred, then in any of these configurations, double-error correction can be performed. One approach requires a further memory WRITE-READ cycle using complemented data and check bits from the DP8400-2. If at least one of the two errors is a hard error, the DP8400-2 will correct both errors. This implementation requires no more memory check bits or DP8400-2s than the single-error correct configurations.

The DP8400-2 has a separate syndrome I/O bus which can be used for error logging or error management. In addition, the DP8400-2 can be used in BYTE-WRITE applications (for up to 72 data bits) because it has separate byte controls for the data buffers. In 16 or 32-bit systems, the DP8400-2 will generate and check system byte parity, if required, for integrity of the data supplied from or to the processor. There are three latch controls to enable latching of data in various modes and configurations.

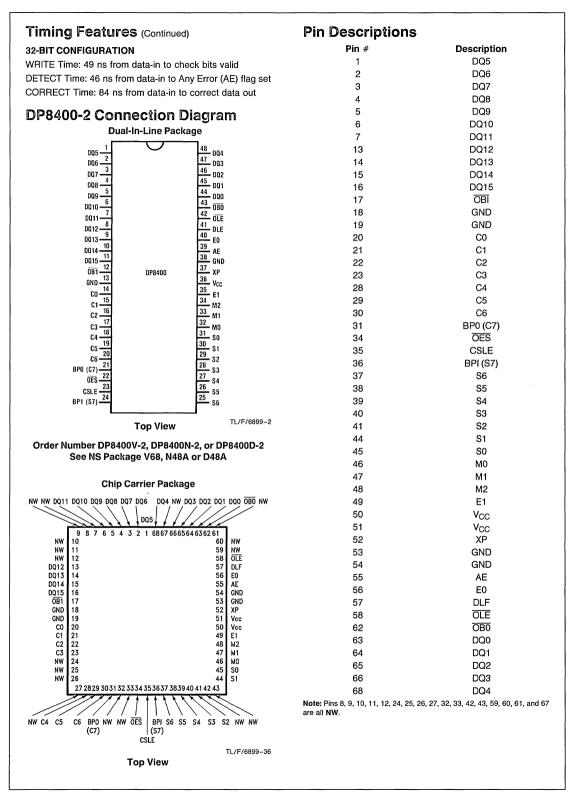
### **Operational Features**

- Fast single and double-error detection
- Fast single-error correction
- Double-error correction after catastrophic failure with no additional ICs or check bits
- Functionally expandable to 100% double-error correct capability
- Functionally expandable to triple-error detect
- Directly expandable to 32 bits using 2 DP8400-2s only
- Directly expandable to 48 bits using 3 DP8400-2s only
- Directly expandable to 64 bits using 4 DP8400-2s only
- □ Expandable to and beyond 64 bits in fast configuration with extra ICs
- □ 3 error flags for complete error recording
- 3 latch enable inputs for versatile control
- Byte parity generating and checking
- Separate byte controls for outputting data in BYTE-WRITE operation
- Separate syndrome I/O port accessible for error logging and management
- On-chip input and output latches for data bus, check bit bus and syndrome bus
- Diagnostic capability for simulating check bits
- Memory check bit bus, syndrome bus, error flags and internally generated syndromes available on the data bus
- E Self-test of E<sup>2</sup>C<sup>2</sup> on the memory card under processor control
- E Full diagnostic check of memory with the E<sup>2</sup>C<sup>2</sup>
- Complete memory failure detectable
- Power-on clears data and syndrome input latches

### **Timing Features**

### **16-BIT CONFIGURATION**

WRITE Time: 29 ns from data-in to check bits valid DETECT Time: 21 ns from data-in to Any Error (AE) flag set CORRECT Time: 44 ns from data-in to correct data out



9

DP8400-2

# DP8400-2

### Pin Definitions See Figure 1 for abbreviations

V<sub>CC</sub>, GND, GND: 5.0V ±5%. The 3 supply pins have been assigned to the center of the package to reduce voltage drops, both DC and AC. Also there are two ground pins to reduce the low-level noise. The second ground pin is located two pins from V<sub>CC</sub>, so that decoupling capacitors can be inserted directly next to these pins. It is important to adequately decouple this device, due to the high switching currents that will occur when all 16 data bits change in the same direction simultaneously. A recommended solution would be a 1  $\mu$ F multiayer ceramic capacitor in parallel with a low-voltage tantalum capacitor, both connected close to pins 36 and 38 to reduce lead inductance.

**DQ0-DQ15:** Data I/O port. 16-bit bidirectional data bus which is connected to the input of DIL0 and DIL1 and the output of DOB0 and DOB1, with DQ8-DQ15 also to CIL.

**C0–C6:** Check-bit I/O port. 7-bit bidirectional bus which is connected to the input of the CIL and the output of the COB. COB is enabled whenever M2 is low.

**S0-S6:** Syndrome I/O port. 7-bit bidirectional bus which is connected to the input of the SIL and the output of the SOB.

**DLE:** Input data latch enable. When high, DIL0 and DIL1 outputs follow the input data bus. When low, DIL0 and DIL1 latch the input data.

**CSLE:** Input check bit and syndrome latch enable. When high, CIL and SIL follow the input check and syndrome bits. When low, CIL and SIL latch the input check and syndrome bits. If  $\overrightarrow{\text{OES}}$  is low, SIL remains latched.

**OLE:** Output latch enable. <u>OLE</u> enables the internally generated data to DOL0, and DOL1, COL and SOL when low, and latches when high.

**XP:** Multi-expansion, which feeds into a three-level comparator. With XP at 0V, only 6 or 7 check bits are available for expansion up to 40 bits, allowing byte parity capability. With XP open or at V<sub>CC</sub>, expansion beyond 40 bits is possible, but byte parity capability is no longer available. When XP is at V<sub>CC</sub>, CG6 and CG7, the internally generated upper two check bits, are set low. When XP is open, CG6 and CG7 are set to word parity.

**BP0 (C7):** When XP is at 0V, this pin is byte-0 parity I/O. In the Normal WRITE mode, BP0 receives system byte-0 parity, and in the Normal READ mode outputs system byte-0 parity. When XP is open or at  $V_{CC}$ , this pin becomes C7 I/O, the eighth check bit for the memory check bits, for 48-bit expansion and beyond.

**BP1 (S7):** When XP is at 0V, this pin is byte-1 parity I/O. In the Normal WRITE mode, BP1 receives system byte-1 parity, and in the Normal READ mode outputs system byte-1 parity. When XP is open or at  $V_{CC}$ , this pin becomes S7 I/O, the eight syndrome bit for 48-bit expansion and beyond.

**AE:** Any error. In the Normal READ mode, when low, AE indicates no error and when high, indicates that an error has occurred. In any WRITE mode, AE is permanently low.

**E0:** In the Normal READ mode, E0 is high for a single-data error, and low for other conditions. In the Normal WRITE mode, E0 becomes PE0 and is low if a parity error exists in byte-0 as transmitted from the processor.

E1: In the Normal READ mode, E1 is high for a single-data error or a single check bit error, and low for no error and double-error. In the Normal WRITE mode, E1 becomes  $\overline{PE1}$  and is low if a parity error exists in byte-1 as transmitted from the processor.

**OB0, OB1:** Output byte-0 and output byte-1 enables. These inputs, when low, enable DOL0 and DOL1 through DOB0 and DOB1 onto the data bus pins DQ0–DQ7 and DQ8–DQ15. When OB0 and OB1 are high the DOB0, DOB1 outputs are TRI-STATE<sup>®</sup>.

**OES:** Output enables syndromes. I/O control of the syndrome latches. When high, SOB is TRI-STATE and external syndromes pass through the syndrome input latch with CSLE high. When OES is low, SOB is enabled and the generated syndromes appear on the syndrome bus, also CSLE is inhibited internally to SIL.

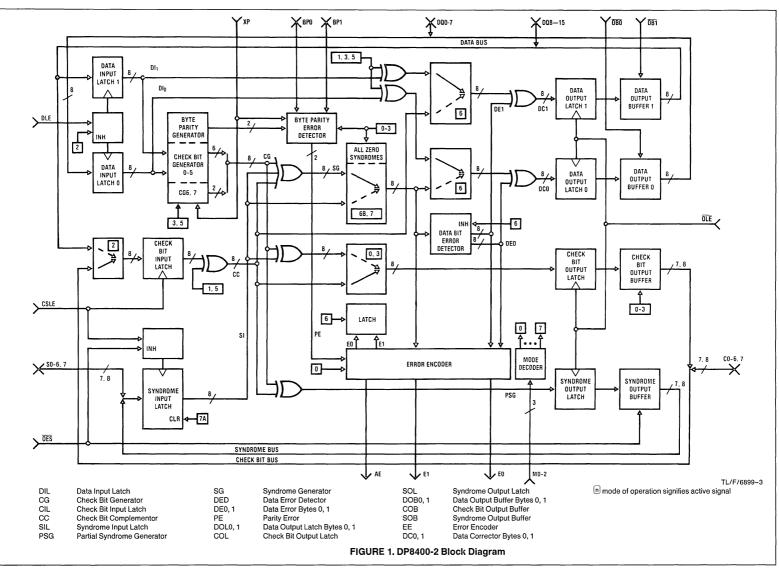
**M0, M1, M2:** Mode control inputs. These three controls define the eight major operational modes of the DP8400-2. Table III depicts the modes.

### System Write (Figure 2a)

The Normal WRITE mode is mode 0 of Table III. Referring to the block diagram in Figure 9a and the timing diagram of Figure 9b, the 16 bits of data from the processor are enabled into the data input latches, DIL0 and DIL1, when the input data latch enable (DLE) is high. When this goes low, the input data is latched. The check bit generator (CG) then produces 6 parity bits, called check bits. Each parity bit monitors different combinations of the input data-bits. In the 16-bit configuration, assuming no syndrome bits are being fed in from the syndrome bus into the syndrome input latch, the 6 check bits enter the check bit output latch (COL), when the output latch enable OLE is low, and are latched in when OLE goes high. Whenever M2 (READ/WRITE) is low, the check bit output buffer COB always enables the COL contents onto the external check bit bus. Also the data error decoder (DED) is inhibited during WRITE so no correction can take place. Data output latches DOL0 and DOL1, when enabled with OLE, will therefore see the contents of DIL0 and DIL1. If valid system data is still on the data bus, a memory WRITE will write to memory the data on the data bus and the check bits output from COB. If the system has vacated the data bus, output enables (OB0 and OB1) must be set low so that the original data word with its 6 check bits can be written to memory.

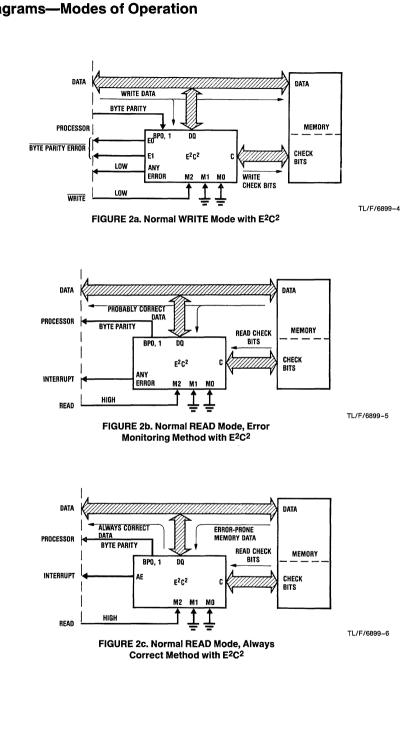
### System Read

There are two methods of reading data: the error monitoring method (Figure 2b), and the always correct method (Figure 2c). Both require fast error detection, and the second, fast correction. With the first method, the memory data is only monitored by the E<sup>2</sup>C<sup>2</sup>, and is assumed to be correct. If there is an error, the Any Error flag (AE) goes high, requiring further action from the system to correct the data. With the always correct method, the memory data is assumed to be possibly in error. Memory data is removed and the corrected, or already correct, data is output from the E2C2 by enabling OB1 and OB0. To detect an error (referring to Figures 10a and 10b) first DLE and CSLE go high to enter data bits and check bits from memory into DIL0, DOL1 and CIL. The 6 check bits generated in CG from DIL0 and DOL1 are then compared with CIL to generate syndromes on the internal syndrome bus (SG). Any bit or bits of SG that go high indicate an error to the error encoder (EE).





# System Diagrams—Modes of Operation



### System Read (Continued)

If data correction is required  $\overline{OB0}$  and  $\overline{OB1}$  must be set low (after memory data has been disabled) to enable data output buffers DOB0 and DOB1. The location of any data bit error is determined by the data error decoder (DED), from the syndrome bits. The bit in error is complemented in the DOL for correction. The other 15 bits from DED pass the DIL contents directly to the DOL, so that DOL now contains corrected data.

### **Error Determination**

The three error flags, for a 16-bit example, are decoded from the internally generated syndromes as shown in *Figure 3*. First, if any error has occurred, the generated check bits will be different from the memory check bits, causing some of the syndrome bits to go high. By OR-ing the syndrome bits, the output will be an indication of any error.

If there is a single-data error, then (from the matrix in Table IV) it can be seen that any data error causes either 3 or 5 syndrome bits to go high. 16 AND gates decode which bit is in error and the bit in error is XOR-ed with the corresponding bit of the DIL to correct it, whereas the other 15 decoder outputs are low, causing the corresponding 15 bits in DIL to transfer to DOL directly. DOL now contains corrected data. The 16 AND gate outputs are OR-ed together causing E0 to go high, so that E0 is the single-data-error indication. If the error is a double-error, then either 2, 4 or 6 of the syndrome bits will be high. The syndromes for two errors (including

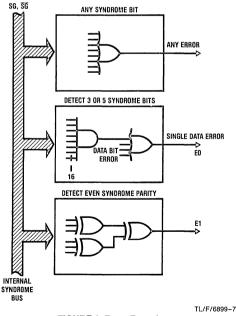


FIGURE 3. Error Encoder

one or two check bit errors) are the two sets of syndromes for each individual error bit, XOR-ed together. By performing a parity check on the syndrome bits, flag E1 will indicate even/odd parity. If there is still an error, but it is not one of these errors, then it is a detectable triple-bit error. Some triple-bit errors are not detectable as such and may be interpreted as single-bit errors and falsely corrected as singledata errors. This is true for all standard ECC circuits using a Modified Hamming-code matrix. The DP8400-2 is capable, with its Rotational Syndrome Word Generator matrix, of determining all triple-bit errors using twice as many DP8400-2s and twice as many check bits.

### **Error Flags**

Three error flags are provided to allow full error determination. Table I shows the error flag outputs for the different error types in Normal READ mode. If there is an error, then ANY ERROR will go high, at a time  $t_{DEV}$  (*Figure 10b*) after data and check bits are presented to the DP8400-2. The other two error flags E0 and E1 become valid  $t_{DE0}$  and  $t_{DE1}$  later.

The error flags differentiate between no error, single check bit error, single data-bit error, double-bit error. Because the DP8400-2 can correct double errors, it is important to know that two errors have occurred, and not just a multiple-error indication. The error flags will remain valid as long as DLE and CSLE are low, or if DLE is high, and data and check bits remain valid.

### Byte Parity Support

Some systems require extra integrity for transmission of data between the different cards. To achieve this, individual byte parity bits are transmitted with the data bits in both directions. The DP8400-2 offers byte parity support for up to 40 data bits. If the processor generates byte parity when transferring information to the memory, during the WRITE cycle, then each byte parity bit can be connected to the corresponding byte parity I/O pin on the DP8400-2, either BP0 or BP1. The DP8400-2 develops its own internal byte parity bits from the two bytes of data from the processor, and compares them with BP0 and BP1 using an exclusive-OR for both parities. The output of each exclusive-OR is fed to the error flags E0 and E1 as PE0 and PE1, so that a byte parity error forces its respective error flag low, as in Table II. These flags are only valid for the Normal WRITE (mode 0) and XP at 0V. The DP8400-2 checks and generates even byte parity.

When transferring information from the memory to the processor, the DP8400-2 receives the memory data, and outputs the corresponding byte parity bits on BP0 and BP1 to the processor. The processor block can then check data integrity with its own byte parity generator. If in fact memory data was in error, the DP8400-2 derives BP0 and BP1 from the corrected data, so when corrected data is output from the DP8400-2, the processor will not detect a byte parity error. During the read mcde, DP8400-2 corrects single data bit error and also its parity. DP8400-2

### TABLE I. Error Flags After Normal Read (Mode 4)

| AE | E1         | E0 | Error Type             |
|----|------------|----|------------------------|
| 0  | 0          | 0  | No error               |
| 1  | 1          | 0  | Single check bit error |
| 1  | 1          | 1  | Single-data error      |
| 1  | 0          | 0  | Double-bit error       |
|    | All Others |    | Invalid conditions     |

### TABLE II. Error Flags after Normal Write (Mode 0)

|    |          | innai tiritto ( |                          |
|----|----------|-----------------|--------------------------|
| AE | E1 (PE1) | E0 (PE0)        | Error Type               |
| 0  | 1        | 1               | No parity error          |
| 0  | 1        | 0               | Parity error, byte 0     |
| 0  | 0        | 1               | Parity error, byte 1     |
| 0  | 0        | 0               | Parity error, bytes 0, 1 |

| All Others        |                                                                                                                                                               | In          | valid | cond  | ditions  |                                                                                                                                                                        |             |                |               |               |              |                      |          |        |        |    |                |
|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-------|-------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|----------------|---------------|---------------|--------------|----------------------|----------|--------|--------|----|----------------|
|                   |                                                                                                                                                               |             | т     | ABL   | E III. D | P840                                                                                                                                                                   | 0-2         | Mod            | es o          | f Ope         | eratio       | on                   |          |        |        |    |                |
|                   | Mode                                                                                                                                                          | M2<br>(R/W) | M1    | мо    | OES      |                                                                                                                                                                        |             |                |               | Оре           | eratio       | on                   |          |        |        |    |                |
|                   | 0                                                                                                                                                             | 0           | 0     | 0     | x        | Norn<br>DIL                                                                                                                                                            |             |                |               | i →           | COL          | _ →                  | CO       | В      |        |    |                |
|                   | 1                                                                                                                                                             | 0           | 0     | 1     | х        | Com<br>DIL                                                                                                                                                             |             |                |               |               | col          | L →                  | · co     | в      |        |    |                |
|                   | 2                                                                                                                                                             | 0           | 1     | 0     | х        | Diag<br>DQ8<br>DQ8                                                                                                                                                     | nosi<br>DC  | tic W<br>Q15 ( | /RITE<br>∌ CG | E, DLI<br>i → | E inh<br>SOl | ibited $\rightarrow$ | i<br>SOI | в      |        |    |                |
|                   | 3 0 1 1 X Complement data-only WRITE<br>$\overline{DIL} \rightarrow DOL,$<br>(CG0, 1, 4, 5, $\overline{CG2}, \overline{CG3}) \rightarrow COL \rightarrow COB$ |             |       |       |          |                                                                                                                                                                        |             |                |               |               |              |                      |          |        |        |    |                |
|                   | 4 1 0 0 X Normal READ<br>DIL $\oplus$ DE $\rightarrow$ DOL, CIL $\rightarrow$ COL                                                                             |             |       |       |          |                                                                                                                                                                        |             |                |               |               |              |                      |          |        |        |    |                |
|                   | 5 1 0 1 X Complement READ<br>DIL $\oplus$ DE $\rightarrow$ DOL, CIL $\rightarrow$ COL                                                                         |             |       |       |          |                                                                                                                                                                        |             |                |               |               |              |                      |          |        |        |    |                |
|                   | 6A                                                                                                                                                            | 1           | 1     | 0     | 0        | REA<br>bus,<br>CIL0<br>E0 -                                                                                                                                            | erro<br>-Cl | r fla<br>L6 -  | gs, S<br>→ C  | G0-8          | SG6          | $\rightarrow$        | DQ0      | -DQ    |        |    |                |
|                   | 6B                                                                                                                                                            | 1           | 1     | 0     | 1        | READ syndrome bus, check bit bus, error<br>flags, SIL0-SIL6 $\rightarrow$ DQ0-DQ6,<br>CIL0-CIL6 $\rightarrow$ DQ8-DQ14, E1 $\rightarrow$ DQ7,<br>E0 $\rightarrow$ DQ15 |             |                |               |               |              |                      |          |        |        |    |                |
|                   | 7A                                                                                                                                                            | 1           | 1     | 1     | 0        | Gene<br>0 →<br>DIL 0                                                                                                                                                   | ≻ S         | IL -           | → S(          | G, CII        |              |                      |          | ero    |        |    |                |
|                   | 7B                                                                                                                                                            | 1           | 1     | 1     | 1        | Gene<br>SIL                                                                                                                                                            |             |                |               |               |              |                      | ⊕ DE     | ∃ →    | DO     | L  |                |
| TABLE IV. Data-In | To Che                                                                                                                                                        | eck Bit (   | Gene  | rate, | Or Da    |                                                                                                                                                                        |             |                |               |               |              |                      |          |        |        |    | Configuration) |
|                   | 0                                                                                                                                                             | 1 2         |       |       | -        | 6                                                                                                                                                                      | 7           | 8              | 9             | 1<br>0        | 1<br>1       | 1<br>2               | 1<br>3   | 1<br>4 | 1<br>5 | }  | DQ0-15         |
| ſ                 |                                                                                                                                                               | ERATE (     |       |       | 1        | 1                                                                                                                                                                      | 1           | 0              | 1             | 1             | 1            | 0                    | 1        | 1      | 1      | 10 | )              |
| 1                 | 0                                                                                                                                                             | 0 0         |       |       | 0        | 1                                                                                                                                                                      | 0           | 1              | 1             | 0             | 1            | 0                    | 1        | 1      | 1      | 1  |                |
| GENERATED 2       | 1                                                                                                                                                             | 0 0         | 1     | 1     | 0        | 0                                                                                                                                                                      | 0           | 1              | 0             | 1             | 0            | 1                    | 1        | 1      | 1      | 2* | GENERATED      |
| SYNDROMES 3       | 0                                                                                                                                                             | 1 1         |       |       |          | 0                                                                                                                                                                      | 1           | 1              | 1             | 1             | 0            | 1                    | 0        | 1      | 1      | 3* | CHECK<br>BITS  |
| 4                 | 1                                                                                                                                                             | 1 0         |       | -     |          | 0                                                                                                                                                                      | 1           | 1              | 0             | 0             | 1            | 0                    | 1        | 0      | 1      | 4  |                |
| 5                 | 1                                                                                                                                                             | 1 1         | 0     | 1     | 1        | 1                                                                                                                                                                      | 0           | 1              | 0             | 0             | 0            | 1                    | 1        | 1      | 0      | 5  | J              |
|                   | 4                                                                                                                                                             | 89          |       |       |          |                                                                                                                                                                        | 9           | E              | в             | D             | 3            | с                    | 7        | F      | F      | 0  |                |
|                   | 3                                                                                                                                                             | 3 2         | 0     | 2     | 3        | 2                                                                                                                                                                      | 1           | 3              | 0             | 0             | 1            | 2                    | 3        | 2      | 1      | 1  |                |
| *C2, C3 ge        | enerate o                                                                                                                                                     | dd parity   |       |       | HE       | ADE<br>OF S                                                                                                                                                            |             |                |               |               | INT          |                      |          |        |        |    | TL/F/6899-8    |

### **Modes of Operation**

There are three mode-control pins, M2, M1 and M0, offering 8 major modes of operation, according to Table III.

M2 is the READ/WRITE control. In normal operation, mode 0 is Normal WRITE and mode 4 is Normal READ. By clamping M0 and M1 low, and setting M2 low during WRITE and high during READ, the DP8400-2 is very easy to use for normal operation. The other modes will be covered in later sections.

### **16-BIT CONFIGURATION**

The first two rows on top of the check bit generate matrix (Table IV) indicate the data position of DQ0 to DQ15. The left side of the matrix, listed 0 to 5, corresponds to syndromes S0 to S5. S0 is the least significant syndrome bit. There are two rows of hexadecimal numbers below the matrix. They are the hex equivalent of the syndrome patterns. For example, syndrome pattern in the first column of the matrix is 001011. Its least significant four bits (0010) equal hexadecimal 4, and the remaining two bits (11) equal hexadecimal 3.

Check bit generation is done by selecting different combinations of data bits and generating parities from them. Each row of the check bit generate matrix corresponds to the generation of a check bit numbered on the right hand side of the matrix, and the ones in that row indicate the selection of data bits.

The following are the check bit generate equations for 16-bit wide data words:

- CG0 = DQ2 ⊕ DQ3 ⊕ DQ4 ⊕ DQ5 ⊕ DQ6 ⊕ DQ7 ⊕ DQ9 ⊕ DQ10 ⊕ DQ11 ⊕ DQ13 ⊕ DQ14 ⊕ DQ15
- \*CG2 = DQ0 ⊕ DQ3 ⊕ DQ4 ⊕ DQ8 ⊕ DQ10 ⊕ DQ12 ⊕ DQ13 ⊕ DQ14 ⊕ DQ15 ⊕ 1
- \*CG3 = DQ1 ⊕ DQ2 ⊕ DQ7 ⊕ DQ8 ⊕ DQ9 ⊕ DQ10 ⊕ DQ12 ⊕ DQ14 ⊕ DQ15 ⊕ 1
- CG4 = DQ0 ⊕ DQ1 ⊕ DQ5 ⊕ DQ7 ⊕ DQ8 ⊕ DQ11 ⊕ DQ13 ⊕ DQ15

\*CG2 and CG3 are odd parities.

The following error map (Table V) depicts the relationship between all possible error conditions and their associated syndrome patterns. For example, if a syndrome pattern is S0-5 = 111101, data bit 14 is in error.

*Figure 4* shows how to connect one DP8400-2 in a 16-bit configuration, in order to detect and correct single or double-bit errors. For a Normal WRITE, processor data is pre-

sented to the DP8400-2, where it is fed through DIL0 and DIL1 to the check bit generator. This generates 6 parity bits from different combinations of data bits, according to Table IV. The numbers in the row below the table are the hexadecimal equivalent of the column bits (with bits 6, 7 low). A "1" in any row indicates that the data bit in that column is connected to the parity generator for that row. For example, check bit 1 generates parity from data bits 3, 6, 8, 9, 11, 13, 14, and 15.

Check bits 0, 1, 4, 5, and 6 generate even parity, and check bits 2 and 3 generate odd parity. This is done to insure that a total memory failure is detected. If all check bits were even parity, then all zeroes in the data word would generate all check bits zero and a total memory failure would not be detected when a memory READ was performed. Now allzero-data bits produce C2 and C3 high and a total memory failure will be detected. When reading back from the same location, the memory data bits (possibly in error) are fed to the same check bit generator, where they are compared to the memory check bits (also possibly in error) using 6 exclusive-OR gates. The outputs of the XORs are the syndrome bits, and these can be determined according to Table IV for one data bit error. For example, an error in bit 2 will produce the syndrome word 101001 (for S5 to S0 respectively). The syndrome word is decoded by the error encoder to the error flags, and the data-error decoder to correct a single data bit error. Assuming the memory data has been latched in the DIL, by making DLE go low, memory data can be disabled. Then by setting OBO and OB1 low, corrected data will appear on the data bus. The syndromes are available as outputs on pins S0-5 when OES is low. It is also possible to feed in syndromes to SIL when OES is high and CSLE goes high. This can be useful when using the Error Management Unit shown in Figure 4. C6 and S6 are not used for 16 bits. It is safe therefore to make C6 appear low, through a 2.7 k $\Omega$ resistor to ground. The same applies for S6 if syndromes are input to the DP8400-2. If OES is permanently low, S6 may be left open.

Any 16-bit memory correct system using the DP8400-2 without syndrome inputs must keep the  $\overline{OES}$  pin grounded, then all the syndrome I/O pins may be left open. The reason for this is that the DP8400-2 resets the syndrome input latch at power up. If the  $\overline{OES}$  pin is grounded, the syndrome input latch will remain reset for normal operations.

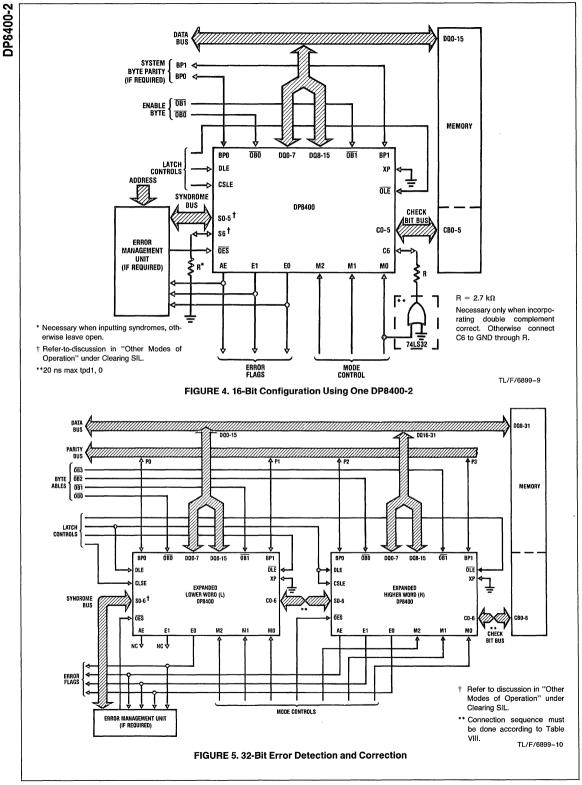
The parameter  $t_{NMR}$  (see *Figure 10b*), new mode recognized time, is measured from M2 (changing from READ to WRITE) to the valid check bits appearing on the check bit bus, provided the  $\overline{OLE}$  was held low.

The parameter  $t_{MCR}$  (see  $\it Figure~10b$ ), mode change recognized time, is measured from M2 (changing from WRITE to

|         |       | S0      | 0          | 1     | 0      | 1        | 0         | 1  | 0      | 1        | 0          | 1       | 0  | 1        | 0        | 1  | 0 | 1  |
|---------|-------|---------|------------|-------|--------|----------|-----------|----|--------|----------|------------|---------|----|----------|----------|----|---|----|
| Syndro  | ome   | S1      | 0          | 0     | 1      | 1        | 0         | 0  | 1      | 1        | 0          | 0       | 1  | 1        | 0        | 0  | 1 | 1  |
| Bits    |       | S2      | 0          | 0     | 0      | 0        | 1         | 1  | 1      | 1        | 0          | 0       | 0  | 0        | 1        | 1  | 1 | 1  |
|         |       | S3      | 0          | 0     | 0      | 0        | 0         | 0  | 0      | 0        | 1          | 1       | 1  | 1        | 1        | 1  | 1 | 1  |
| S5      | S4    |         |            |       |        |          |           |    |        |          |            |         |    |          |          |    |   |    |
| 0       | 0     |         | NE         | C0    | C1     | D        | C2        | D  | D      | 3        | C3         | D       | D  | 9        | D        | 10 | Т | D  |
| 0       | 1     |         | C4         | D     | D      | 11       | D         | Т  | Т      | D        | D          | 7       | Т  | D        | Т        | D  | D | 15 |
| 1       | 0     |         | C5         | D     | D      | 6        | D         | 4  | Т      | D        | D          | 2       | Т  | D        | 12       | D  | D | 14 |
| 1       | 1     |         | D          | 5     | Т      | D        | 0         | D  | D      | 13       | 1          | D       | D  | Т        | D        | Т  | 8 | D  |
| E=no en | ror C | Cn=chec | k bit n in | error | T = th | ree erro | rs detect | ed | Number | = single | data bit i | n error | D= | two bits | in error |    |   |    |

ABLE V. Syndrome Decode To Bit In Error For 16-Bit Data Word





### Modes of Operation (Continued)

READ) when both E1 and E2 become invalid. This is required when a memory correcting system employs the DP8400-2 with byte parity checking. The E1 and E2 pins flag the byte parity error in a memory WRITE cycle. When the DP8400-2 switches to a subsequent memory READ cycle, it requires t<sub>MCR</sub> for E1 and E2 to be switched to flag any READ error(s).

### **Expanded** Operation

### 32-BIT CONFIGURATION

Figure 5 shows how to connect two DP8400-2s in cascade to detect single and double-bit errors, and to correct singledata errors. The same circuit will also correct double-bit errors once a double-error has been detected, provided at least one error is a hard error. The lower chip L is in effect a slave to the higher chip H, which controls the memory check bits and error reporting. The check bit bus of L is reordered and connected to the syndrome bus of H, as shown in Figure 5.

In a Normal WRITE mode, referring to Figures 13a, 13b, and 13c, the 7 check bits generated from the lower 16 bits (CGL) are transferred via the COL to the COB of L, provided OLE is high and M2 (R/W) of L is low. These partial check bits from L then appear at SIL of H, so that with CSLE high, they combine with the 6 check bits generated in H with an overlap of one bit, to produce 7 check bits. With M2 ( $R/\overline{W}$ ) of H low, these 7 check bits are output from COB to memory.

A READ cycle may consist of DETECT ONLY or DETECT THEN CORRECT, depending on the system approach. In both approaches, L writes its partial check bits, CGL, to H as in WRITE mode. H develops the syndrome bits from CGL, CGH and the 7 check bits read from memory in CIL. H then outputs from its error encoder (EE) if there is an error. If corrected data is required, H already knows if it has a single-data error from its syndrome bits, but if not, it must transfer partial syndromes back to L. These partial syndromes PSH, (CGH XOR-ed with CIL), are stored in SOL of H. L must therefore change modes from WRITE to READ, while H outputs the partial syndromes from its SOB by setting OES low. The partial syndromes are fed into CIL of L and XOR-ed with CGL to produce syndrome bits at SGL. The data error decoder, DED, then corrects the error in L. The DED of H will already have corrected an error in the higher 16 bits. Only one error in 32 bits can be corrected as a single-data error, the chip with no error does not change the contents of its DIL when it is enabled in DOL. Table VI shows the 3 error flags of H, which become valid during the DETECT cycle. E0 of L becomes valid during the CORRECT cycle, so that the 4 flags provide complete error reporting.

**TABLE VI. Error Flags After Normal READ** (32-Bit Configuration)

| AE (H) | E1 (H) | E0 (H) | E0 (L)* | Error Type                |
|--------|--------|--------|---------|---------------------------|
| 0      | 0      | 0      | 0       | No error                  |
| 1      | 1      | 0      | 0       | Single-check bit error    |
| 1      | 1      | 1      | 0       | Single-data bit error (H) |
| 1      | 1      | 0      | 1       | Single-data bit error (L) |
| 1      | 0      | 0      | 0       | Double-bit error          |
|        | All C  | thers  |         | Invalid conditions        |

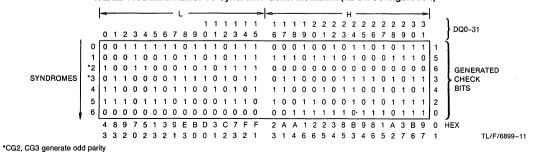
\*E0 (L) is valid after transfer of partial syndromes from higher to lower Equations for 32-bit expansion:

 $t_{DCB32} = t_{DCB16} + t_{SCB16}$  $t_{DEV32} = t_{DCB16} + t_{SEV16}$  $t_{DCD32}$  (High Chip) =  $t_{DCB16} + t_{SCD16}$  $t_{DCD32}$  (Low Chip) =  $t_{DCB16} + t_{BR}^* + t_{CCD16}$ \*tBB: Bus reversing time (25 ns)

### 32-BIT MATRIX

Table VII shows a 32-bit matrix using two DP8400-2s in cascade as in Figure 5. This is one of 12 matrices that work for 32 bits. The matrix for bits 0 to 15 (lower chip) is the matrix of Table IV for 16-bit configuration, with row 6 always "0". The matrix for bits 16 to 31 (higher chip) uses the same row combinations but interchanged, for example, the 3rd row (row 2) of L matrix is the same as the 6th row (row 5) of the H matrix. This means row 5 of H is in fact check bit 2 of H. Thus, the 6th row (row 5) combines generated check bit 5 (CG5) of L and generated check bit 2 of H. Check bit 5 of L therefore connects to the syndrome bit 2 (CG2) of H, and the composite generated check bit is written to check bit 2 of memory. Thus C2 performs a parity check on bits 0, 1, 2, 4, 5, 6, 8, 12, 13, 14, of L, and bits 16, 19, 20, 24, 26, 28, 29, 30, 31, of H. CG2 and CG3 generate odd parity, so that CG5 of L generates even parity which combines with CG2 of H generating odd parity. CG3 of L and CG3 of H both generate odd parity causing C3 to memory to represent even parity. Only 6 check bits are generated in each chip, the 7th (CG6) is always zero with XP grounded. Thus CG6 of L combines with CG0 of H so that C0 to memory is the parity of bits 18, 19, 20, 21, 22, 23, 25, 26, 27, 29, 30, 31. Similarly C6 to memory is only CG2 of L. The 7 composite generated check bits of H can now be written to memory.

When reading data and check bits from memory, CG6-CG0 of L are combined with CG6-CG0 of H in the same combination as WRITE. Memory check bits are fed into C6-C0 of H and compared with the 7 combined parity bits in H, to



# TABLE VII. Data Bit Error To Syndrome-Generate Matrix (32-Bit Configuration)

### Expanded Operation (Continued) TABLE VIII. Check Bit Port To Syndrome Port Interconnections For Expansion To 32 Bits

|                  |            |                      |             |             |                  |                                        |                                 |                                 | <u> </u>                        |                  |                            |                                        |                  |                  |                  |             |             |             |       |
|------------------|------------|----------------------|-------------|-------------|------------------|----------------------------------------|---------------------------------|---------------------------------|---------------------------------|------------------|----------------------------|----------------------------------------|------------------|------------------|------------------|-------------|-------------|-------------|-------|
|                  |            |                      |             |             |                  |                                        | L<br>S                          | L<br>C                          | H<br>S                          |                  | H<br>C                     |                                        |                  |                  |                  |             |             |             |       |
|                  |            |                      | Mana        | to<br>geme  | /O<br>nt         | S0<br>S1<br>S2<br>S3<br>S4<br>S5<br>S6 | 0<br>1<br>2<br>3<br>4<br>5<br>6 | 0<br>1<br>2<br>3<br>4<br>5<br>6 | 1<br>5<br>6<br>3<br>4<br>2<br>0 |                  | 5<br>6<br>3<br>4<br>2<br>0 | C0<br>C1<br>C2<br>C3<br>C4<br>C5<br>C6 |                  | to<br>Merr       | iory             |             |             |             |       |
|                  |            | TA                   | BLEI        | X. Sy       | ndro             | me [                                   | Decod                           | le To                           | Bit I                           | n Eri            | or F                       | For 3                                  | 32-E             | Bit Da           | ta W             | ord         |             |             |       |
| Syndrome<br>Bits |            | S0<br>S1<br>S2<br>S3 | 0<br>0<br>0 | 1<br>0<br>0 | 0<br>1<br>0<br>0 | 1<br>1<br>0<br>0                       | 0<br>0<br>1<br>0                | 1<br>0<br>1<br>0                | 0<br>1<br>1<br>0                | 1<br>1<br>1<br>0 |                            | 5                                      | 1<br>0<br>0<br>1 | 0<br>1<br>0<br>1 | 1<br>1<br>0<br>1 | 0<br>0<br>1 | 1<br>0<br>1 | 0<br>1<br>1 | 1 1 1 |
| S6               | <b>S</b> 5 | <b>S</b> 4           |             | •           | •                | •                                      | Ū                               | •                               | Ū                               | •                |                            | •                                      | •                | •                | •                | •           | •           | •           | .     |
| 0                | 0          | 0                    | NE          | C0          | C1               | D                                      | C2                              | D                               | D                               | 3                | С                          | 3                                      | D                | D                | 9                | D           | 10          | Т           | D     |
| 0                | 0          | 1                    | C4          | D           | D                | 11                                     | D                               | Т                               | Т                               | D                | 1                          | 5                                      | 7                | 17               | D                | Т           | D           | D           | 15    |
| 0                | 1          | 0                    | C5          | D           | D                | 6                                      | D                               | 4                               | Т                               | D                | 0                          | 5                                      | 2                | 28               | D                | 12          | D           | D           | 14    |
| 0                | 1          | 1                    | D           | 5           | 16               | D                                      | 0                               | D                               | D                               | 13               | 1                          | 1                                      | D                | D                | 24               | D           | Т           | 8           | D     |
| 1                | 0          | 0                    | C6          | D           | D                | 22                                     | D                               | Т                               | Т                               | D                | 0                          | ) i                                    | 25               | 18               | D                | Т           | D           | D           | Т     |
| 1                | 0          | 1                    | D           | 27          | 21               | D                                      | Т                               | D                               | D                               | Т                | 2                          | 3                                      | D                | D                | Т                | D           | Т           | Т           | D     |
| 1                | 1          | 0                    | D           | 19          | 20               | D                                      | Т                               | D                               | D                               | Т                | 2                          | 6                                      | D                | D                | 30               | D           | Т           | Т           | D     |
| 1                | 1          | 1                    | Т           | D           | D                | 29                                     | D                               | Т                               | Т                               | D                |                            | ) :                                    | 31               | Т                | D                | Т           | D           | D           | Т     |
|                  |            |                      |             | 0.          | -                |                                        | in our                          |                                 | - 46.44                         |                  |                            |                                        |                  |                  |                  |             |             |             |       |

NE=no error Number=single data bit in error Cn=check bit n in error D=two bits in error T=three errors detected

produce 7 syndrome bits S6–S0. H can now determine if there is any error, and if it has a single-data error, it can locate it and correct it without transferring partial syndromes to L. As an example of a DETECT cycle, CG5 of L combines with CG2 of H and is compared in H with memory check bit 2.

If L is now set to mode 4, Normal READ, and  $\overline{\text{OES}}$  of H is set low, the partial syndromes of H (CG6–CG0 of H XOR-ed with C6–C0 of H) are transferred and shifted to L. L receives these partial syndromes (S6–S0 of H) as check bit inputs C2, C1, C4, C3, C5, C0, C6 respectively, and compares them with CG6–CG0 respectively, to produce syndrome bits S6–S0. L now decodes these syndromes to correct any single-data error in data bits 0 to 15. For example, partial syndrome bit 2 of H combines with generated check bit 5 of L to produce syndrome bit 5 in L. An error in data bit 10 will create syndrome bits S6–S0 of L with  $\overline{\text{OES}}$  low. An error in H will appear as per the H matrix. For example, an error in bit 16 will cause S6–S0 of L to be 0110010.

If  $\overline{\text{OES}}$  of L is set low, this syndrome combination appears on pins S6 to S0. For errors in bits 0 to 15, the syndrome outputs will be according to Table VII. For errors in bits 16 to 31, the syndrome outputs from L will still be according to Table VII due to the shifting of partial syndrome bits from H to L. The syndrome outputs from L are unique for each of the possible 32 bits in error.

If there is a check bit error, only one syndrome bit will be high. For example, if C5 is in error, then S1 of L will be high. For double-errors, an even number of syndrome bits will be high, derived from XOR-ing the two single-bit error syndromes. As mentioned previously, this is only one of the 12 approaches to connecting two chips for 32 bits, 6 of which are mirror images. Table VIII depicts the exact connection for 32-bit expansion. LS equals syndrome bits of L. LC equals check bits of L. HS equals syndrome bits of H. HC equals check bits of H. Syndrome bits S0 to S6 of L are connected to system syndrome bits S0 to S6. LC and HS columns are lined together showing the check bit port of L connected to the syndrome port of H in the exact sequence as shown in Table VIII. For example, check bit C0 of L is connected to the syndrome bit S1 of H, and check bit G0 of L is connected to the syndrome bit S0 of H. Check bits of H are connected to the syndrome bit S0 of H. Check bits of H are connected to the system check bits in the order show. Check bit C1 of H is connected to the system check bit C0.

### EXPANSION FOR DATA WORDS REQUIRING 8 CHECK BITS

For 16-bit and 32-bit configurations, XP is set permanently low. In 48-bit or 64-bit configurations, XP is either set permanently to  $V_{CC}$  or left open, according to Table X, to provide 8 check bits and syndrome bits.

| TABLE X. XP: Expansion State |
|------------------------------|
|------------------------------|

|                 | TADLE A. A Expansion otata                       | <b>v</b>  |
|-----------------|--------------------------------------------------|-----------|
| ХР              | Status                                           | Data Bus  |
| 0V              | BP0 and BP1 are byte parity I/O<br>CG6=0         | < 40 Bits |
| Open            | No byte parity I/O,<br>CG6 and CG7 = word parity | ≥ 40 Bits |
| V <sub>CC</sub> | No byte parity I/O,<br>CG6 and CG7=0             | ≥ 40 Bits |

### **48-BIT EXPANSION**

Three DP8400-2s are required for 48 bits, with the higher chip using all 8 of its check bits to the memory. No byte parity is available for 48 to 64 bits. XP of all three chips must be at V<sub>CC</sub>. The three chips are connected in cascade as in

| E)                 | pan         | Ideo   | d Op                       | erat                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | tion                            | TA       | BLE                        | XI. Che<br>nnectio                   |                                      |           |                                 |                  |                                      |                                              |                  |                      |          |        |          |    |
|--------------------|-------------|--------|----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|----------|----------------------------|--------------------------------------|--------------------------------------|-----------|---------------------------------|------------------|--------------------------------------|----------------------------------------------|------------------|----------------------|----------|--------|----------|----|
|                    |             |        |                            |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                 |          | LL                         | LL                                   |                                      |           | I HL                            |                  | HL                                   |                                              |                  |                      |          |        |          |    |
|                    |             |        |                            |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | lrome l <i>i</i><br>to<br>ageme | 53       | 1<br>2<br>3<br>4<br>5<br>6 | 0<br>1<br>2<br>3<br>4<br>5<br>6<br>7 | 1<br>5<br>6<br>3<br>4<br>2<br>0<br>7 |           | 6<br>1<br>4<br>7<br>2<br>3<br>5 |                  | 6<br>1<br>4<br>7<br>2<br>3<br>5<br>0 | C0<br>C1<br>C2<br>C3<br>C4<br>C5<br>C6<br>C7 | t                | Bit I/C<br>o<br>mory |          |        |          |    |
|                    |             |        |                            | LH is c                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | onnected                        | to S6 o  | f HL. C                    | 6 of HL is                           | conne                                | cted to s | ystem c                         | heck t           | oit CO                               |                                              | I to S1 of       |                      | of       |        |          |    |
| Syne<br>Bits<br>S7 | drome<br>S6 | S5     | S0<br>S1<br>S2<br>S3<br>S4 | TABLE XII. Syndrome Decode To Bit In Error For 48-Bit Data Word           0         1         0         1         0         1         0         1           0         1         0         1         0         1         0         1         0         1           0         0         1         1         0         0         1         1         0         1         1           0         0         0         1         1         1         0         0         1         1           0         0         0         1         1         1         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0         0 |                                 |          |                            |                                      |                                      |           |                                 | 0<br>0<br>1<br>1 | 1<br>0<br>1<br>1                     | 0<br>1<br>1<br>1                             | 1<br>1<br>1<br>1 |                      |          |        |          |    |
| 0                  | 0           | 0      | 0                          | NE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | CO                              | C1       | D                          | C2                                   | D                                    | D         | 3                               | C                | 3                                    | D                                            | D                | 9                    | D        | 10     | Т        | D  |
| 0                  | 0           | 0      | 1                          | C4                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | D                               | D        | 11                         | D                                    | Т                                    | Т         | D                               |                  | 5                                    | 7                                            | 17               | D                    | Т        | D      | D        | 15 |
| 0                  | 0           | 1      | 0                          | C5                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | D                               | D        | 6                          | D                                    | 4                                    | Т         | D                               | [                | 2                                    | 2                                            | 28               | D                    | 12       | D      | D        | 14 |
| 0                  | 0           | 1      | 1                          | D                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | 5                               | 16       | D                          | 0                                    | D                                    | D         | 13                              |                  |                                      | D                                            | D                | 24                   | D        | Т      | 8        | D  |
| 0                  | 1           | 0      | 0                          | C6                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | D                               | D        | 22                         | D                                    | Т                                    | Т         | D                               |                  | )                                    | 25                                           | 18               | D                    | Т        | D      | D        | Т  |
| 0                  | 1           | 0      | 1                          | D                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | 27                              | 21       | D                          | 32                                   | D                                    | D         | Т                               | 2                | -                                    | D                                            | D                | Т                    | D        | T      | Т        | D  |
| 0                  | 1           | 1      | 0                          | D                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | 19                              | 20       | D                          | 33                                   | D                                    | D         | T                               | 2                |                                      | _D                                           | D                | 30                   | D        | Т      | T        | D  |
| 0                  | 1           | 1      | 1                          | 44                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | D                               |          | 29                         | D                                    | Т                                    | 40        | D                               |                  |                                      | 31                                           | T                | D                    | T        | D      | D        | T  |
|                    | 0           | 0      | 0                          | C7                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |                                 | D        |                            |                                      | T                                    | 43        | D                               |                  |                                      |                                              | T                | D                    | Т        |        | D        | T  |
|                    | 0           | 0      | 1                          | D                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | T<br>T                          | 35       |                            | T                                    | D                                    | D         | T                               |                  | -                                    |                                              | D                | T                    | D        | T<br>T | Т<br>  Т | D  |
|                    | 0<br>0      | 1      | 0<br>1                     | D<br>42                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |                                 | 41<br>D  | <br>Т                      | 39<br>D                              | D                                    | D<br>47   |                                 |                  | -                                    | D<br>T                                       | <u>р</u><br>Т    | T<br>D               | D<br>T   |        |          | D  |
|                    | 1           | 1<br>0 | 0                          | <br>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | <u> </u>                        | 38       |                            | 37                                   |                                      | 47<br>D   | T                               |                  | _                                    | _ <u> </u>                                   |                  | <u></u><br>Т         | D        |        | Т        |    |
|                    | 1           | 0      | 1                          | 36                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | D                               |          | <br>                       | D                                    | T                                    | 45        |                                 |                  |                                      | _ <u></u> т                                  | T                |                      | <u> </u> |        |          |    |
| 1                  | 1           | 1      | 0                          | 34                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | D                               | D        |                            | D                                    | T                                    | T         | D                               |                  | -+-                                  | <u>т</u>                                     | T                | D                    | T        | D      |          | T  |
| 1                  | 1           | 1      | 1                          | D                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | Т                               | 46       | D                          | Т                                    | D                                    | D         | T                               |                  | r                                    | <br>D                                        | D                | Т                    | D        | T      | Т        | D  |
| NE                 | = no err    | or     |                            |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | Cn = c                          | neck bit | n in erro                  | or T=                                | three                                | errors d  | etected                         |                  |                                      |                                              | 1                | L                    | L        | L      | 1        | L  |

NE = no error Number = single data bit in error D = two bits in error

Figure 6, but with the HH chip removed. The error flags are as Table XV, but with AE (HH) and E1 (HH) becoming AE (HL) and E1 (HL), and E0 (HH) removed.

### **48-BIT MATRIX**

The matrix for 48 bits is that for 64 bits shown (in Table XVI) but only using bits 0 to 47. This is one of many matrices for 48-bit expansion using the basic 16-bit matrix. The matrix shown uses 2 zeroes for CG6 and CG7, for all three chips, with XP set to V<sub>CC</sub>. Other matrices may use CG6 and CG7 as word parity with XP open.

### 64-BIT EXPANSION

There are two basic methods of expansion to 64 bits, both requiring 8 check bits to memory, and four DP8400-2s. One is the cascade method of Figure 6, requiring no extra ICs. With this method partial check bits have to be transferred through three chips in the WRITE or DETECT mode, and partial syndrome bits transferred back through three chips in CORRECT mode. This method is similar to Figure 5, 32-bit approach. The connections between the check bit bus

and syndrome bus for each of the chip pairs are shown in Table XIII.

The error flags of HH are valid during the DETECT cycle as in Table XV, and the other error flags are valid during the CORRECT cycle.

A faster method of 64-bit expansion shown in Figure 7 requires a few extra ICs, but can WRITE in 50 ns, DETECT in 42 ns or DETECT THEN CORRECT in 90 ns. In the WRITE mode, all four sets of check bits are combined externally in the 8 74S280 parity generators. These generate 8 composite check bits from the system data, which are then enabled to memory. In the DETECT mode, again 8 composite check bits are generated, from the memory data this time, and compared with the memory check bits to produce 8 external syndrome bits. These syndrome bits may be OR-ed to determine if there is any error. By making the 74S280 outputs SYNDROMES, then any bit low causes the 74S30 NAND gate to go high, giving any error indication. To correct the error, these syndrome bits are fed re-ordered into SIL of each DP8400-2 now set to mode 7B. This enables the syndromes directly to SG and then DED of each chip. One chip

Cn = check bit n in error

T = three errors detected

# DP8400-2

### Expanded Operation (Continued)

will output corrected data, while the other three output nonmodified data (but still correct).

Equations for fast 64-bit expansion:

| $t_{DCB64} = t_{DCB16} + t_{pd} (74S280) + t_{pd} (74S240)$     |
|-----------------------------------------------------------------|
| $t_{DEV64} = t_{DCB16} + t_{pd} (74S280) + t_{pd} (74S30)$      |
| $t_{DCB64} = t_{DCB16} + t_{pd}$ (74S280) + $t_{pd}$ (74ALS533) |
| + t <sub>SCD16</sub>                                            |

### 64-BIT MATRIX

With the 64-bit matrix shown in Table XVI, it is necessary to set at least one chip with CG6, CG7 non-zero. The highest chip, connected to data bits 48 to 63, has XP set open, so that its CG6 and CG7 are word parity. The syndrome word of the highest chip will now have either 5 or 7 syndrome bits high, but inside the chip CG6 and CG7 remove two of these in a READ so that the chip sees the normal 3 or 5 syndrome bits.

### **TABLE XIII. Check Bit Port To Syndrome Port** Interconnections For Expansion To 64 Bits

|                                  |                                        | LL<br>S                         | LL<br>C                         | LH<br>S                         | LH<br>C                         | HL<br>S                         | HL<br>C                         | HH<br>S                         | HH<br>C                         |                                        |                               |
|----------------------------------|----------------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|----------------------------------------|-------------------------------|
| Syndrome I/O<br>to<br>Management | S0<br>S1<br>S2<br>S3<br>S4<br>S5<br>S6 | 0<br>1<br>2<br>3<br>4<br>5<br>6 | 0<br>1<br>2<br>3<br>4<br>5<br>6 | 1<br>5<br>6<br>3<br>4<br>2<br>0 | 1<br>5<br>6<br>3<br>4<br>2<br>0 | 6<br>1<br>4<br>7<br>2<br>3<br>5 | 6<br>1<br>4<br>7<br>2<br>3<br>5 | 7<br>0<br>1<br>2<br>3<br>4<br>5 | 7<br>0<br>1<br>2<br>3<br>4<br>5 | C0<br>C1<br>C2<br>C3<br>C4<br>C5<br>C6 | Check Bit I/O<br>to<br>Memory |
|                                  | S7                                     | 7                               | 7                               | 7                               | 7                               | 0                               | 0                               | 6                               | 6                               | C7                                     |                               |

For example: S0 of LL is connected to system syndrome S0. C0 of LL is connected to S1 of LH. C1 of LH is connected to S6 of HL. C6 of HL is connected to S7 of HH. C7 of HH is connected to system check bit C0.

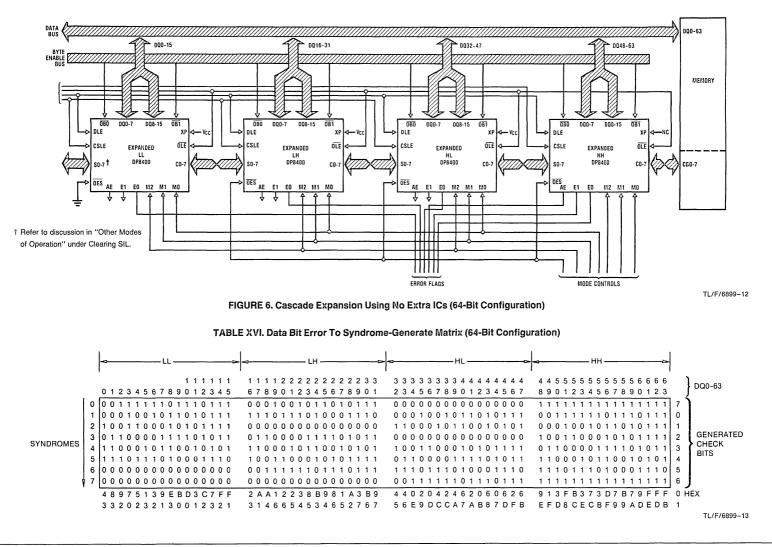
| TABLE XIV. Syndrome Decode To Bit In Error For 64-Bit Data Word |            |    |                |             |             |             |             |             |             |             |             |             |             |             |             |             |             |             |             |
|-----------------------------------------------------------------|------------|----|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Syne                                                            | drome      | •  | S0<br>S1<br>S2 | 0<br>0<br>0 | 1<br>0<br>0 | 0<br>1<br>0 | 1<br>1<br>0 | 0<br>0<br>1 | 1<br>0<br>1 | 0<br>1<br>1 | 1<br>1<br>1 | 0<br>0<br>0 | 1<br>0<br>0 | 0<br>1<br>0 | 1<br>1<br>0 | 0<br>0<br>1 | 1<br>0<br>1 | 0<br>1<br>1 | 1<br>1<br>1 |
| S7                                                              | <b>S</b> 6 | S5 | S3<br>S4       | 0           | 0           | 0           | 0           | 0           | 0           | 0           | 0           | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1.          |
| 0                                                               | 0          | 0  | 0              | NE          | C0          | C1          | D           | C2          | D           | D           | 3           | C3          | D           | D           | 9           | D           | 10          | Т           | D           |
| 0                                                               | 0          | 0  | 1              | C4          | D           | D           | 11          | D           | Т           | Т           | D           | D           | 7           | 17          | D           | Т           | D           | D           | 15          |
| 0                                                               | 0          | 1  | 0              | C5          | D           | D           | 6           | D           | 4           | Т           | D           | D           | 2           | 28          | D           | 12          | D           | D           | 14          |
| 0                                                               | 0          | 1  | 1              | D           | 5           | 16          | D           | 0           | D           | D           | 13          | 1           | D           | D           | 24          | D           | Т           | 8           | D           |
| 0                                                               | 1          | 0  | 0              | C6          | D           | D           | 22          | D           | Т           | Т           | D           | D           | 25          | 18          | D           | Т           | D           | D           | т           |
| 0                                                               | 1          | 0  | 1              | D           | 27          | 21          | D           | 32          | D           | D           | Т           | 23          | D           | D           | Т           | D           | Т           | Т           | D           |
| 0                                                               | 1          | 1  | 0              | D           | 19          | 20          | D           | 33          | D           | D           | Т           | 26          | D           | D           | 30          | D           | Т           | Т           | D           |
| 0                                                               | 1          | 1  | 1              | 44          | D           | D           | 29          | D           | Т           | 40          | D           | D           | 31          | Т           | D           | Т           | D           | D           | Т           |
| 1                                                               | 0          | 0  | 0              | C7          | D           | D           | Т           | D           | Т           | 43          | D           | D           | Т           | Т           | D           | Т           | D           | D           | 51          |
| 1                                                               | 0          | 0  | 1              | D           | Т           | 35          | D           | Т           | D           | D           | 57          | Т           | D           | D           | 58          | D           | Т           | Т           | D           |
| 1                                                               | 0          | 1  | 0              | D           | Т           | 41          | D           | 39          | D           | D           | 59          | Т           | D           | D           | Т           | D           | Т           | Т           | D           |
| 1                                                               | 0          | 1  | 1              | 42          | D           | D           | 55          | D           | Т           | 47          | D           | D           |             | Т           | D           | Т           | D           | D           | 63          |
| 1                                                               | 1          | 0  | 0              | D           | Т           | 38          | D           | 37          | D           | D           | 54          | Т           | D           | D           | 52          | D           | Т           | Т           | D           |
| 1                                                               | 1          | 0  | 1              | 36          | D           | D           | 50          | D           | Т           | 45          | D           | D           | 60          | Т           | D           | Т           | D           | D           | 62          |
| 1                                                               | 1          | 1  | 0              | 34          | D           | D           | 53          | D           | Т           | Т           | D           | D           | 48          | Т           | D           | Т           | D           | D           | 61          |
| 1                                                               | 1          | 1  | 1              | D           | 49          | 46          | D           | Т           | D           | D           | Т           | Т           | D           | D           | Т           | D           | 56          | Т           | D           |

### NE = no error Number = single data bit in error D = two bits in error

Cn = check bit n in errorT = three errors detected

### TABLE XV. Error Flags After Normal READ (Any 64-Bit Configuration)

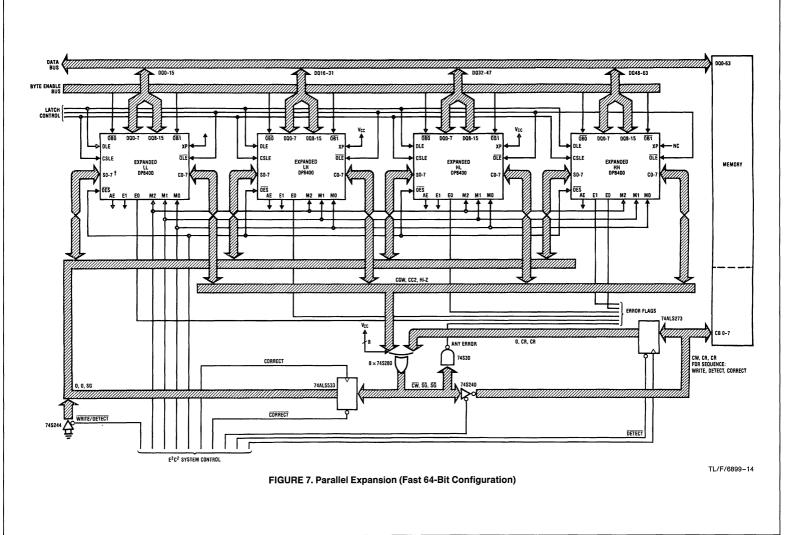
| AE (HH) | E1 (HH) E0 (HH) |   | E0 (HL) | E0 (LH) | E0 (LL) | Error Type                  |  |  |
|---------|-----------------|---|---------|---------|---------|-----------------------------|--|--|
| 0       | 0               | 0 | 0       | 0       | 0       | No error                    |  |  |
| 1       | 1               | 0 | 0       | 0       | 0       | Single-check bit error      |  |  |
| 1       | 1               | 1 | 0       | 0       | 0       | Single-data bit error in HH |  |  |
| 1       | 1               | 0 | 1       | 0       | 0       | Single-data bit error in HL |  |  |
| 1       | 1               | 0 | 0       | 1       | 0       | Single-data bit error in LH |  |  |
| 1       | 1               | 0 | 0       | 0       | 1       | Single-data bit error in LL |  |  |
| 1       | 0               | 0 | 0       | 0       | 0       | Double-error                |  |  |



2-21

R

DP8400-2



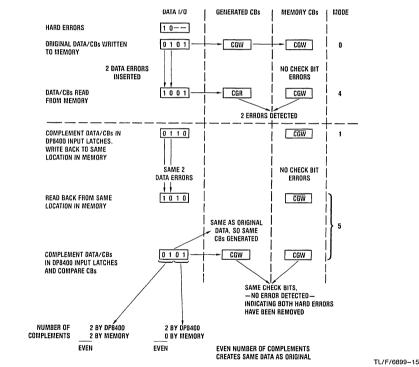
### **Other Modes Of Operation**

### DOUBLE ERROR CORRECTION, USING THE DOUBLE-COMPLEMENT APPROACH

The DP8400-2 can be made to correct two errors, using no extra ICs or check bits, if at least one of the two errors detected is a hard error. This does require an extra memory WRITE and READ. Nevertheless, if a permanent failure exists, and an additional error occurs (creating two errors), both errors can be corrected, thereby saving a system crash.

Once a double error has been detected, the system puts the DP8400-2 in COMPLEMENT mode by setting M0 high. First a WRITE cycle is required and M2 is set low, putting the chip in mode 1, Table III, (COMPLEMENT WRITE), so that the contents of DIL are complemented into DOL, and the contents of CIL complemented into COL. OB0 and OB1 are set low so that complemented data and check bits can be written back to the same location of memory. Writing back complemented data to a location with a hard error forces

the error to repeat itself. For example, if cell N of a particular location is jammed permanently high, and a low is written to it, a high will be read. However, when the data is complemented a low is again written, so that a high is read back for the second time. After a second READ (this second READ is a COMPLEMENT READ) of the location, data and check bits from the memory are recomplemented, so that bit N now contains a low. In other words, the error in bit N has corrected itself, while the other bits are true again. If there are two hard errors in a location, both are automatically corrected and the DP8400-2 detects no error on COMPLE-MENT READ, as in Figure 8a. Figure 8b also shows that if one error is soft, the hard error will disappear on the second READ and the DP8400-2 corrects the soft error as a singleerror. Therefore, in both cases, the DOL contains corrected data, ready to be enabled by OBO and OB1. A WRITE to memory at this stage removes the complemented data written at the start of the sequence.





#### Other Modes of Operation (Continued)

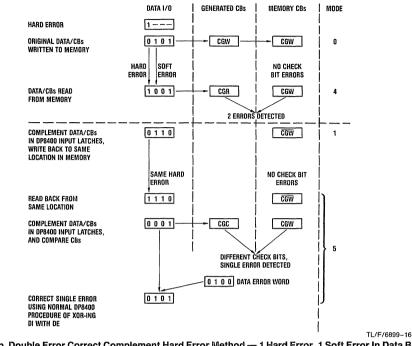


FIGURE 8b. Double Error Correct Complement Hard Error Method — 1 Hard Error, 1 Soft Error In Data Bits

The examples shown in *Figures 8a* and *8b* are for 4 data bits. This approach will work for any number of data bits, but for simplicity these examples show how complementing twice corrects two errors in the data bits. The double COM-PLEMENT approach also works for any two errors providing at least one is hard. In other words, one data-bit error and one check bit error, or two check bit errors are also corrected if one or both are hard. At the end of the COMPLEMENT READ cycle, the error flags indicate whether the data was correctable or not, as shown in Table XVII. If both the error flags indicate this.

This approach is ideal where double errors are rare but may occur. To avoid a system crash, a double-error detect now causes the system to enter a subroutine to set the DP8400-2 in COMPLEMENT mode. This method is also useful in bulk-memory applications, where RAMs are used with known cell failures, and is applicable in 16, 32, 48 or 64-bit

configuration. In the 16-bit configuration, modes 1 and 5 of Table III are used. In the 32-bit expanded configuration, modes 1, 5 and 5 are used for the highest chip, and modes 3, 3 and 4 for the lower chip for WRITE, DETECT, and COR-RECT. With the lower chip it is necessary to wrap around DOL (after latching its contents in mode 3), back to DIL and perform a Normal READ in mode 4 in the lower chip.

TABLE XVII. ERROR FLAGS AFTER COMPLEMENT READ (MODE 5)

| AE | E1 | E0 | Error Type                               |
|----|----|----|------------------------------------------|
| 0  | 0  | 0  | Two hard errors                          |
| 1  | 1  | 0  | One hard error, one soft check bit error |
| 1  | 1  | 1  | One hard error, one soft data bit error  |
| 1  | 0  | 0  | Two soft errors, not corrected           |

#### Other Modes of Operation (Continued)

#### DOUBLE-ERROR CORRECT WITH ERROR LOGGING

Figures 4 and 5 show the  $E^2C^2$  syndrome port connected to an error management unit (EMU). This scheme stores syndromes and the address of locations that fail, thereby logging the errors. Subsequent errors in a memory location that has already stored syndromes in the EMU, can then be removed by injecting the stored syndromes of the first error. To save the addresses and syndromes when power to the EMU is removed, it is necessary to be able to transfer information via the  $E^2C^2$  syndrome port to the processor data bus. This is also useful for logging the errors in the processor.

#### DATA BUS TO SYNDROME BUS TRANSFER

This is necessary when transferring syndrome information to the error management unit, which is connected to the external syndrome bus. First, data to make CG = 0 (all data bits high) must be latched in DIL. Then in mode 2, data is fed to CIL, XOR-ed with 0, and output via SOL with  $\overline{OES}$  low to the syndrome bus. Data is therefore fed directly from the system to the syndrome bus, and this cycle may be repeated as long as DLE is kept low, forcing CG to remain zero.

#### SYNDROME BUS TO DATA BUS TRANSFER

This is important when information in the error logger or error management unit has to be read. The DP8400-2 is set to mode 6B with  $\overrightarrow{OES}$  high, and with  $\overrightarrow{OB0}$ ,  $\overrightarrow{OB1}$  and  $\overrightarrow{OLE}$ low. If CSLE is high, the syndrome bus and check bit bus data appear on the lower and upper bytes of the data bus to be read by the system. Also E1 and E0 values that were valid when mode 6 was entered, appear on DQ7 and DQ15.

#### FULL DIAGNOSTIC CHECK OF MEMORY

Using mode 2, it is possible to transfer the upper byte of the data bus directly to the ClL, with CSLE high, without affecting DIL. These simulated check bits then appear on the check bit bus with  $\overline{\text{OLE}}$  low, which also causes the previous-ly latched contents of DIL to transfer to DOL. By enabling  $\overline{\text{OB0}}$  and  $\overline{\text{OB1}}$  data can be written to memory with the simulated check bits. A Normal READ cycle can then aid the system in determining that the memory bits are functioning correctly, since the processor knows the check bits and data it sent to the E<sup>2</sup>C<sup>2</sup>. Another solution is to put the E<sup>2</sup>C<sup>2</sup> in mode 6 and read the memory check bits directly back to the processor.

#### SELF-TEST OF THE E<sup>2</sup>C<sup>2</sup> ON-CARD

Again using mode 2, data written from the processor data bus upper byte to CIL may be stored in CIL, by taking CSLE low. Next, a mode 0 WRITE can be performed and the user generated data can be latched in the DP8400-2 input latches (DLE held low). Now the user may perform a normal mode 4 READ. This will in effect be a Diagnostic READ of the user generated data and check bits without using the external memory. Thus by reading corrected data in mode 4, and by reading the generated syndromes, and error flags E0 and E1, the DP8400-2 can be tested completely on-card without involving memory.

#### MONITORING GENERATED SYNDROMES AND MEMORY CHECK BITS

Mode 6A enables SG0–SG6 onto DQ0–DQ6, and CILO–CIL6 onto DQ8–DQ14, provided  $\overline{OLE}$ ,  $\overline{OB0}$  and  $\overline{OB1}$  are low. Also the two error flags, E1 and E0 (latched from the previous READ mode), appear on DQ7 and DQ15. This may be used for checking the internal syndromes, for reading the memory check bits, or for diagnostics by checking the latched error flags.

#### CLEARING SIL

In the 16-bit only configuration, or the lower chip of expanded configurations, and in various modes of operation in the higher expanded chips, it is required that SIL be maintained at zero. At power-up initialization, both SIL and DIL are reset to all low. If  $\overline{OES}$  is kept low, SIL will remain reset because CSLE is inhibited to SIL. Another method is to keep  $\overline{OES}$  always high and the syndrome bus externally set low, or set low whenever CSLE can be used to clear SIL.

Mode 7A also forces the SIL to be cleared whenever CSLE occurs, and also these zero syndromes go to the internal syndrome bus SG. This puts the DP8400-2 in a PASS-THROUGH mode where the DIL contents pass to DOL and CIL contents to COL, if  $\overline{\text{OLE}}$  is low.

#### POWER-UP INITIALIZATION OF MEMORY

Both SIL and DIL are reset low at power-up initialization. This facilitates writing all zeroes to the memory data bits to set up the memory. The check bits corresponding to all-zero data will appear on the check bit bus if the DP8400-2 is set to mode 0 and  $\overline{OLE}$  is set low. All-zero data appears on the data bus when  $\overline{OB0}$  and  $\overline{OB1}$  are also set low. The system can now write zero-data and corresponding check bits to every memory location.

#### BYTE WRITING

*Figure 14a* shows the block diagram of a 16-bit memory correction system consisting of a DP8400-2 error correction chip and a DP8409A DRAM controller chip. There are 12 control signals associated with the interface. Six of the signals are standard DP8400-2 input signals, three are standard DP8409A input signals, and three are buffer control signals. The buffer control signals, PBUF0 and PBUF1, control when data words or bytes from the DP8400-2/memory data bus are gated to the processor are gated to the DP8400-2/memory data bus.

When the processor is reading or writing bytes to memory, words will always be read or written by the DP8400-2 and DP8409A error correction and DRAM controller section. The High Byte Enable and Address Data Bit Zero signals from the processor should control the byte transfers via the ocal bus transceiver signals PBUF0 and PBUF1. The buffer control signal, DOUTB, controls when data from memory is gated onto the DP8400-2/memory data bus.

*Figure 14b* shows the timing relationships of the 12 control signals, along with the DP8400-2/memory data bus and some of the DRAM control signals ( $\overline{RAS}$  and  $\overline{CAS}$ ). RGCK is the  $\overline{RAS}$  generator clock of the DP8409A which is used in Mode 1 (Auto Refresh mode), along with being the system clock.



#### Other Modes of Operation (Continued)

Having two separate byte enable pins. OB0 and OB1, it is easy to implement byte writing using the DP8400-2. First it is necessary to read from the location to which the byte is to be written. To do this the DP8400-2 is put in normal Read mode (Mode 4), which will detect and correct a single bit error. WIN is kept high and RASIN is pulled low, causing the DP8409A, now in Mode 5 (Auto Access mode), to start a read memory cycle. The data word and check bits from memory are then enabled onto the DP8400-2/memory data bus by pulling DOUTB low. The data and check bits are valid on the bus after the RASIN to CAS time (tBAC) plus the column access time (t<sub>CAC</sub>) of the particular memories used. DLE, CSLE can then be pulled low in order to latch the memory data into the input latches of the DP8400-2. OLE can be pulled low to enable the corrected memory word, or the original memory word if no error was present, into the data output latches. Following this, DOUTB can be pulled high to disable the memory data from the DP8400-2/memory data bus. The corrected memory word will be available at the data output latches "t<sub>DCD16</sub>" after the memory word was available at the data input latches. Once the corrected data is available at the output latches OLE can be pulled high to latch the corrected data. Also DLE and CSLE can be pulled high in order to enable the input data latches again. Now the DP8400-2 can be put into a write cycle (Mode 0 =M2 = Low). At this time the byte to be written to memory and the other byte from memory can be enabled onto the DP8400-2/memory data bus (OB0, PBUF1 or OB1, PBUF0 go low). DLE, CSLE can now transition low to latch the new memory word into the data input latch. OLE is pulled low to enable the output latches. When the new checkbits are valid, t<sub>DCB16</sub> after the data word is valid on the DP8400-2/ memory data bus, OLE and DLE can be pulled high to latch the new memory word into the output latches, and then WIN can be pulled low to write the data into memory. RASIN should be held low long enough to cause the new data and check bits to be stored into memory (WIN data hold time).

Also a READ-MODIFY-WRITE cycle was performed, taking approximately 40% longer than a normal memory WRITE cycle. A READ and then a WRITE memory cycle could have been used in the above example but it would have taken longer.

Buffers are used in this system (74ALS244) to keep the Data Out and Data In of the memory IC's from conflicting with each other during Read-Modify-Write cycles.

A byte READ from memory is no different from a normal READ. This approach may be used for a 16-bit processor using byte writing, or an 8-bit processor using a 16-bit memory to reduce the memory percentage of check bits, or with memory word sizes greater than two bytes.

An APP NOTE (App Note 387) has been written detailing an Error Correcting Memory System using the DP8409A or DP8419 (Dynamic RAM Controller) and the DP8400-2 interfaced to a National Semiconductor Series 32000 CPU. See this App Note for further system details and considerations.

#### BEYOND SINGLE-ERROR CORRECT

With the advent of larger semiconductor memories, the frequency of the soft errors will increase. Also some memory system designers may prefer to buy less expensive memories with known cell, row or column failures, thus, more hard errors. All this means that double-error correct, triple-error detect capability, and beyond will become increasingly important. The DP8400-2 can correct two errors, provided one or both are hard errors, with no extra components, using the double complement approach. There are two other approaches to enhance reliability and integrity. One is to use the error management unit to log errors using the syndrome bus, and then to output these syndromes, when required, back to the DP8400-2.

#### DOUBLE SYNDROME DECODING

The other approach takes advantage of the Rotational Syndrome Word Generator matrix. This matrix is an improvement of the Modified Hamming-code, so that if, on a second DP8400-2, the data bus is shifted or rotated by one bit, and 2 errors occur, the syndromes for this second chip will be different from the first for any 2 bits in error. Both chips together output a unique set of syndromes for any 2 bits in error. This can be decoded to correct any 2-bit error. This is not possible with other Modified Hamming-code matrices.

| Absolute Maximum Ra             | tings (Note 1)  |
|---------------------------------|-----------------|
| Storage Temperature Range       | -65°C to +150°C |
| Supply Voltage, V <sub>CC</sub> | 7V              |
| Input Voltage                   | 5.5V            |

Output Sink Current

Molded Package

Maximum Power Dissipation at 25°C

Lead Temperature (Soldering, 10 seconds)

\*Derate molded package 26.2 mW/°C above 25°C.

#### **Operating Conditions**

|                                      | Min  | Max  | Units |
|--------------------------------------|------|------|-------|
| V <sub>CC</sub> , Supply Voltage     | 4.75 | 5.25 | v     |
| T <sub>A</sub> , Ambient Temperature | 0    | 70   | °C    |

#### **Electrical Characteristics** (Note 2) $V_{CC} = 5V \pm 5\%$ , $T_A = 0^{\circ}C$ to 70°C unless otherwise noted

50 mA

300°C

3269 mW

| Symbol                   | Parameter                                          | Conditions                                                                                           | Min        | Тур        | Max        | Units  |
|--------------------------|----------------------------------------------------|------------------------------------------------------------------------------------------------------|------------|------------|------------|--------|
| VIL                      | Input Low Threshold                                |                                                                                                      |            |            | 0.8        | v      |
| V <sub>IH</sub>          | Input High Threshold                               |                                                                                                      | 2.0        |            |            | V      |
| V <sub>C</sub>           | Input Clamp Voltage                                | $V_{CC} = Min, I_C = -18 mA$                                                                         |            | -0.8       | -1.5       | v      |
| IIH                      | Input High Current                                 | $V_{IN} = 2.7V$                                                                                      |            | 1          | 160        | μΑ     |
| I <sub>IH</sub> (XP)     | Input High Current                                 | $V_{CC} = Max, XP = 5.25V$                                                                           |            | 2.5        | 4.5        | mA     |
| I <sub>IL</sub> (XP)     | Input Low Current                                  | $V_{CC} = Max, XP = 0V$                                                                              |            | -2.5       | -4.5       | mA     |
| I <sub>IL</sub> (BP0/C7) | Input Low Current                                  | $V_{CC} = Max, V_{IN} = 0.5V$                                                                        |            | -100.0     | -500       | μA     |
| I <sub>IL</sub> (BP1/S7) | Input Low Current                                  | $V_{CC} = Max, V_{IN} = 0.5V$                                                                        |            | 100.0      | -500       | μA     |
| I <sub>IL</sub> (CSLE)   | Input Low Current                                  | $V_{CC} = Max, V_{IN} = 0.5V$                                                                        |            | -150.0     | -750       | μΑ     |
| I <sub>IL</sub> (DLE)    | Input Low Current                                  | $V_{CC} = Max, V_{IN} = 0.5V$                                                                        |            | -200.0     | -1000      | μΑ     |
| կլ                       | Input Low Current                                  | $V_{CC} = Max, V_{IN} = 0.5V$                                                                        |            | -50.0      | -250       | μΑ     |
| lj –                     | Input High Current (Max)                           | V <sub>IN</sub> = 5.5V (Except XP Pin)                                                               |            |            | 1.0        | mA     |
| V <sub>OL</sub>          | Output Low Voltage                                 | $I_{OL} = 8 \text{ mA} \text{ (Except BP0, BP1)}$<br>$I_{OL} = 4 \text{ mA} \text{ (BP0, BP1 Only)}$ |            | 0.3<br>0.3 | 0.5<br>0.5 | V<br>V |
| V <sub>OH</sub>          | Output High Voltage                                | $I_{OH} = -100 \mu A$<br>$I_{OH} = -1 m A$                                                           | 2.7<br>2.4 | 3.2<br>3.0 |            | V<br>V |
| los                      | Output Short Current<br>(Note 3)                   | V <sub>CC</sub> = Max                                                                                |            | - 150      | - 250      | mA     |
| Icc                      | Supply Current                                     | V <sub>CC</sub> = Max                                                                                |            | 220        | 300        | mA     |
| C <sub>IN</sub> (I/O)    | Input Capacitance All<br>Bidirectional Pins        | Note 4                                                                                               |            | 8.0        |            | pF     |
| C <sub>IN</sub>          | Input Capacitance All<br>Unidirectional Input Pins | Note 4                                                                                               |            | 5.0        |            | pF     |

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: All typical values are for  $T_A = 25^{\circ}C$  and  $V_{CC} = 5.0V$ Note 3: Only one output at a time should be shorted.

Note 4: Input capacitance is guaranteed by periodic testing. F test=10 kHz at 300 mV,  $T_A=25^{\circ}C$ .

Note 5: All switching parameters measured from 1.5V of input to 1.5V of output. Input pulse amplitude 0V to 3V, tr=tf=2.5 ns.

**t**DPE

t<sub>DCP</sub>

Error Flags Valid Data in Valid to Corrected

Byte Parity Output Valid

#### DP8400-2 Switching Characteristics (Note 5) $V_{CC} = 5.0V \pm 5\%$ , $T_A = 0^{\circ}C$ to 70°C, $C_L = 50 \text{ pF}$ Symbol Parameter Conditions Min Тур Max Data Input Valid to Figure 9b 29 40 tDCB16 Check Bit Valid Data Input to Any Figures 10b, 11b 21 31 t<sub>DEV16</sub> Error Valid (Note 1) Data Input Valid to Figure 10b, OB0, OB1 Low 44 61 tDCD16 Corrected Data Valid Data Input Set-Up Time Figures 10b, 13d 10 5 t<sub>DSI</sub> Before DLE, CSLE H to L Data Input Hold Time Figures 10b, 13d 10 5 tDHI After DLE, CSLE H to L Data Input Set-Up Time Figure 10b 10 5 t<sub>DSO</sub> Before OLE L to H Data Input Hold Time Figure 10b 10 5 t<sub>DHO</sub> After OLE L to H Data in Valid to E0 Valid Figures 9b, 10b, 13d 36 55 t<sub>DE0</sub> Data in Valid to E1 Valid Figures 9b, 10b, 13d 55 43 t<sub>DE1</sub> DLE, CSLE High to Any Figure 10b Error Flag Valid (Input 28 45 t<sub>IEV</sub> Data Previously Valid) DLE, CSLE High to Any 38 60 t<sub>IEX</sub> Figures 9b, 10b Error Flag Invalid DLE, CSLE High Width to Guarantee Valid Data Figures 10b, 13d 20 **t**ILE I atched OLE Low Width to Guarantee Valid Data Figure 13d 20 tOLE Latched High Impedance to Logic 1 from OB0, OB1, OES Figures 9b, 10b, 13d 22 36 tzн M2 H to L Logic 1 to High Impedance from OBO, Figures 9b, 10b, 13d, 38 55 t<sub>HZ</sub> OB1, OES, M2 L to H High Impedance to Logic t<sub>ZL</sub> 0 from OB0, OB1, OES Figures 9b, 10b, 13d 19 35 M2 H to L Logic 0 to High Impedance from OB0, Figures 9b, 10b, 13d 15 25 t<sub>LZ</sub> OB1, OES, M2 H to L Byte Parity Input Valid Figure 9b 16 27 **t**PPE to Parity Error Flags Valid Data In Valid to Parity

Units

ns

27

44

55

61

Note 1: This parameter value holds given that an error occurred. In the case of no error, tDEV16 will be max of 80 ns.

Figures 9b, 13d

Figure 9b

DP8400-2

### **DP8400-2 Switching Characteristics** (Continued) (Note 5) $V_{CC} = 5.0V \pm 5\%$ T<sub>A</sub> = 0°C to 70°C C<sub>1</sub> = 50 pF

| Symbol             | Parameter                                                 | Conditions               | Min | Тур | Max | Units |
|--------------------|-----------------------------------------------------------|--------------------------|-----|-----|-----|-------|
| t <sub>NMR</sub>   | New Mode Recognize<br>Time                                | Figure 10b               |     | 22  | 35  | ns    |
| t <sub>CDV</sub>   | Mode Valid to<br>Complement Data Valid                    | Figure 11b               |     | 34  | 50  | ns    |
| tccv               | Mode Valid to<br>Complement Check Bit<br>Valid            | Figure 11b               |     | 30  | 45  | ns    |
| tSCB               | Syndrome Input Valid to<br>Check Bit Valid                | Figure 13d               |     | 20  | 35  | ns    |
| tSEV               | Syndrome Input Valid<br>(CGL) to Any Error Valid          | Figure 13d               |     | 17  | 27  | ns    |
| tSCD               | Syndrome Inputs Valid to<br>Corrected Data Valid          | Figure 13d               |     | 35  | 50  | ns    |
| t <sub>DSB</sub>   | Data Input Valid to<br>Syndrome Bus Valid                 | Figure 13d, OES Low      |     | 28  | 46  | ns    |
| tCSB               | Check Bit Inputs Valid<br>to Syndrome Bus Valid           | Figure 13d, OES Low      |     | 19  | 32  | ns    |
| tCEV               | Check Bit Inputs Valid<br>(PSH) to Any Error Valid        | Figure 13d               |     | 17  | 30  | ns    |
| tCCD               | Check Bit Input Valid<br>(PSH) to Corrected Data<br>Valid | Figure 13d               |     | 30  | 45  | ns    |
| tDCB32             | Data Input Valid to Check<br>Bit Valid                    | Figure 13d               |     | 49  | 75  | ns    |
| t <sub>DEV32</sub> | Data Input Valid to Any<br>Error Valid                    | Figure 13d               |     | 46  | 67  | ns    |
| t <sub>DCD32</sub> | Data Input Valid to<br>Corrected Data Out                 | Figure 13d, OB0, OB1 Low |     | 84  | 110 | ns    |

Note 1: "Absolute Maximum Ratings" are the values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

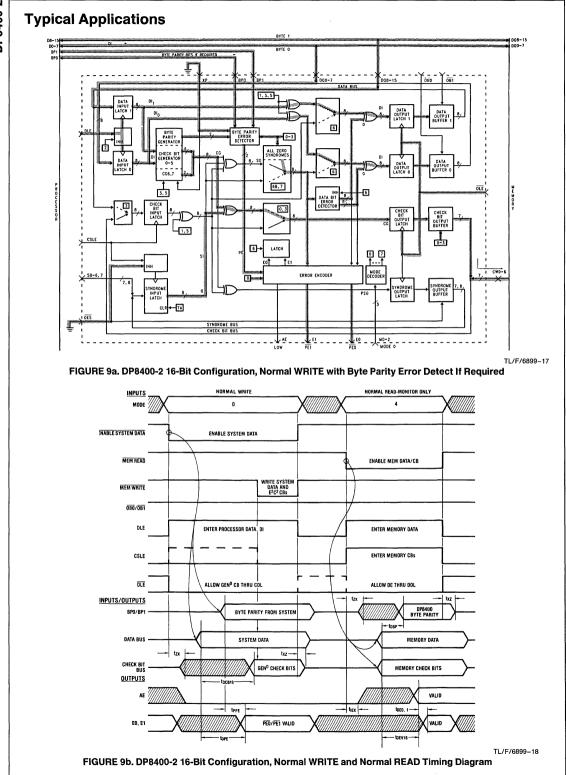
Note 2: All typical values are for  $T_A = 25^{\circ}C$  and  $V_{CC} = 5.0V$ .

Note 3: Only one output at a time should be shorted.

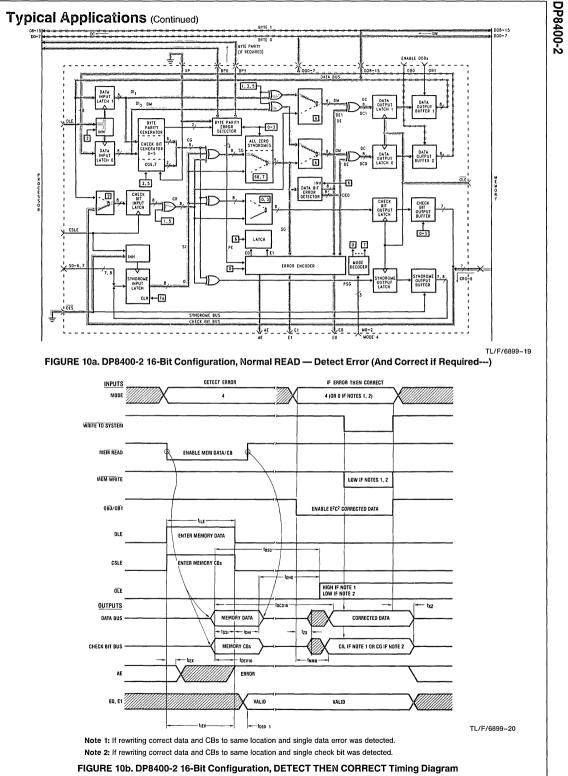
Note 4: Input capacitance is guaranteed by periodic testing. F test=10 kHz at 300 mV, TA=25°C.

Note 5: All switching parameters measured from 1.5V of input to 1.5V of output. Input pulse amplitude 0V to 3V, tr=tf=2.5 ns.



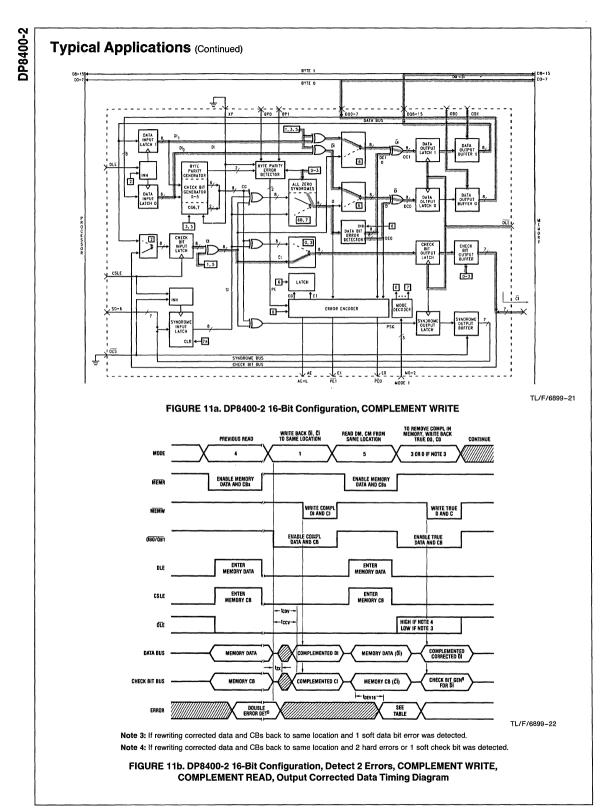


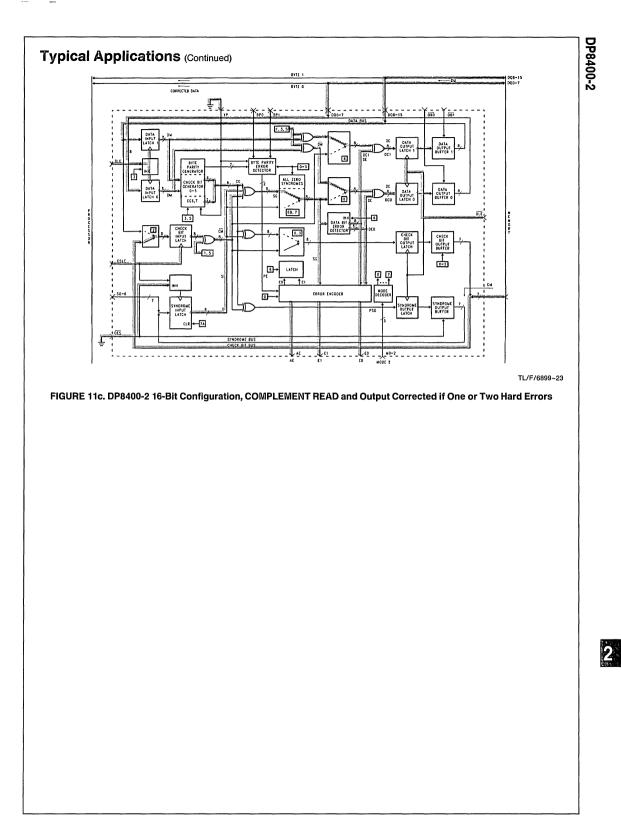
# DP8400-2

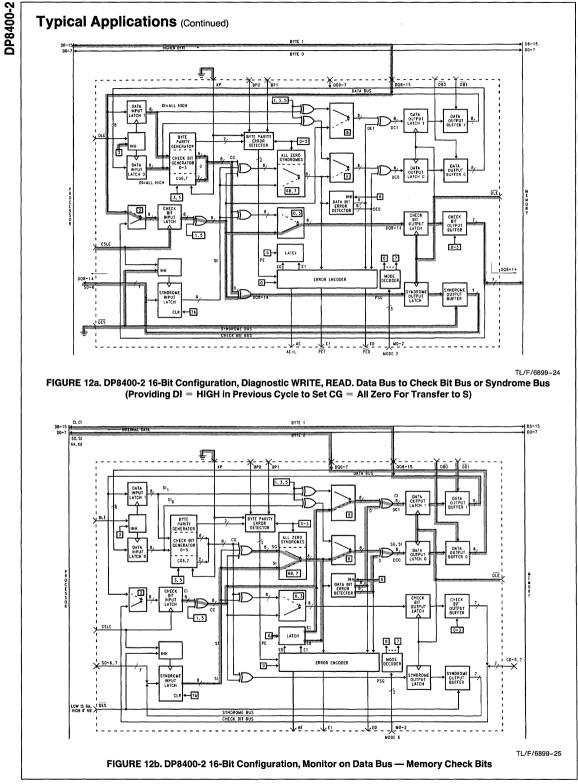


2-31

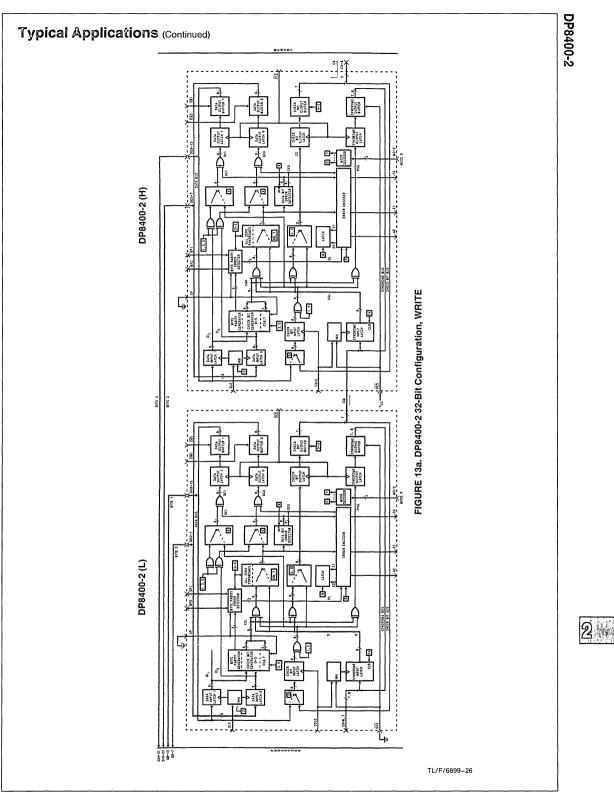
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2-34

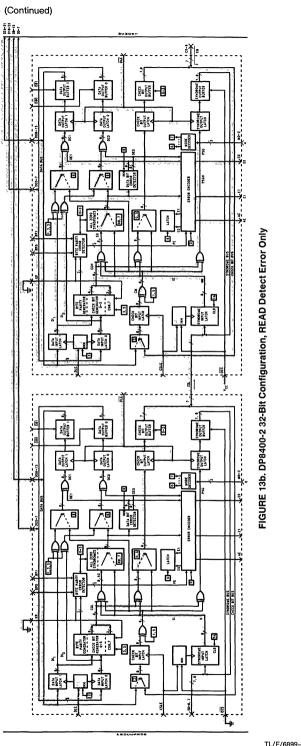


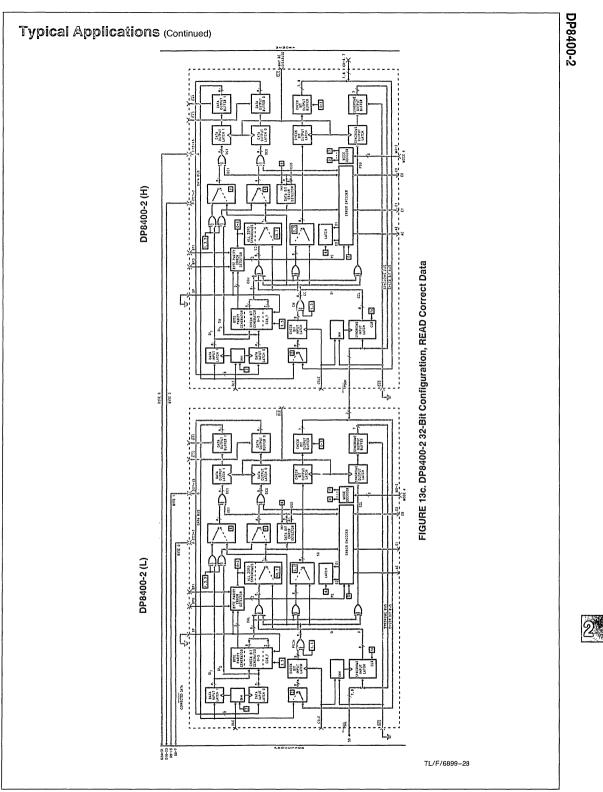


#### Typical Applications (Continued)

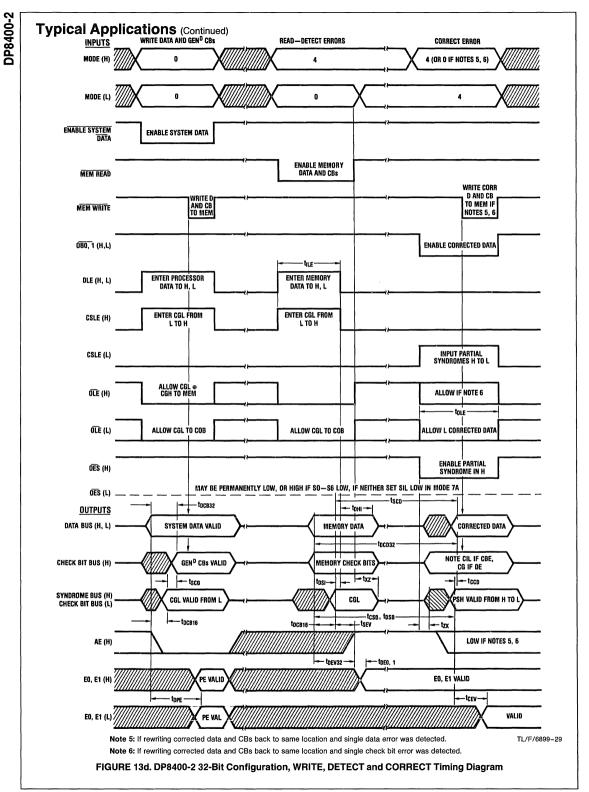
DP8400-2 (H)

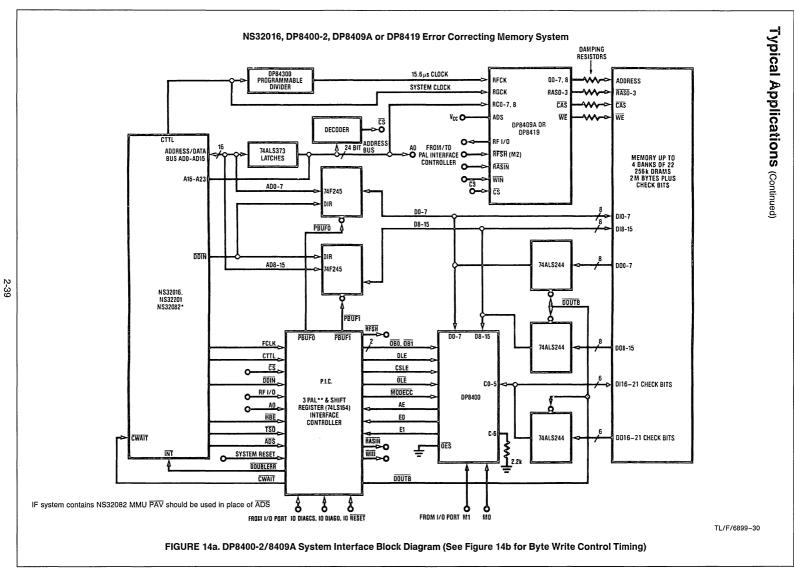
DP8400-2 (L)



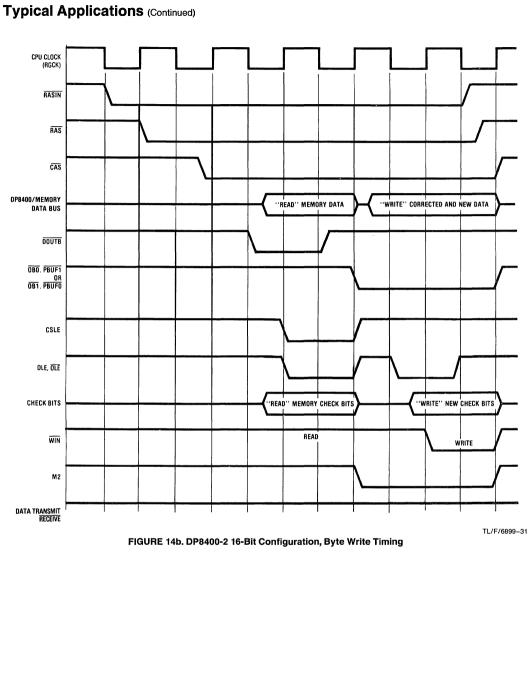


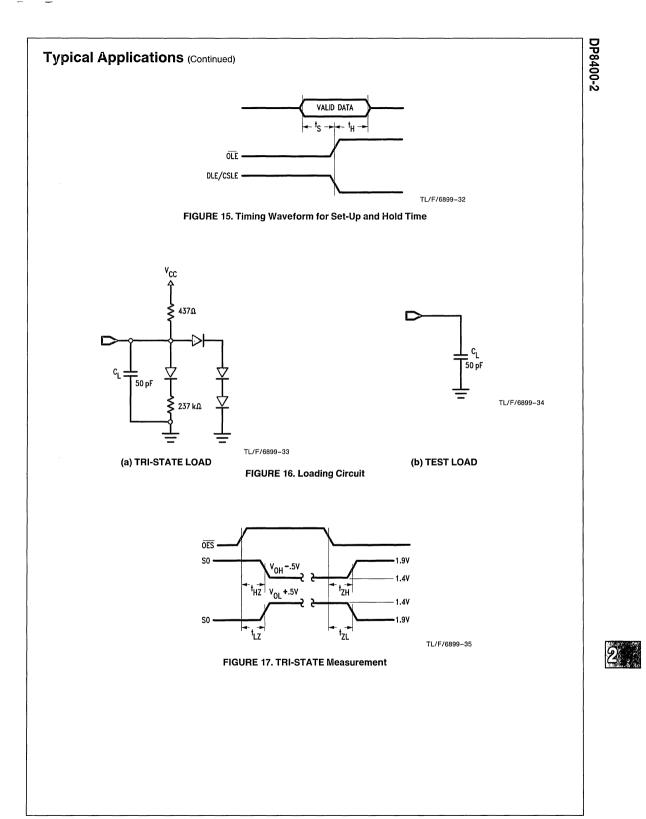
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DP8400-2







#### PRELIMINARY

#### DP8402A/DP8403/DP8404/DP8405 32-Bit Parallel Error Detection and Correction Circuits (EDAC's)

#### **General Description**

The DP8402A, DP8403, DP8404 and DP8405 devices are 32-bit parallel error detection and correction circuits (EDACs) in 52-pin DP8402A and DP8403 or 48-pin DP8404 and DP8405 600-mil packages. The EDACs use a modified Hamming code to generate a 7-bit check word from a 32-bit data word. This check word is stored along with the data word during the memory write cycle. During the memory read cycle, the 39-bit words from memory are processed by the EDACs to determine if errors have occurred in memory.

Single-bit errors in the 32-bit data word are flagged and corrected.

Single-bit errors in the 7-bit check word are flagged, and the CPU sends the EDAC through the correction cycle even though the 32-bit data word is not in error. The correction cycle will simply pass along the original 32-bit data word in this case and produce error syndrome bits to pinpoint the error-generating location.

Double bit errors are flagged but not corrected. These errors may occur in any two bits of the 39-bit word from memory (two errors in the 32-bit data word, two errors in the 7-bit check word, or one error in each word). The gross-error condition of all lows or all highs from memory will be detected. Otherwise, errors in three or more bits of the 39-bit word are beyond the capabilities of these devices to detect.

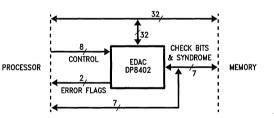
Read-modify-write (byte-control) operations can be performed with the DP8402A and DP8403 EDACs by using output latch enable,  $\overline{\text{LEDBO}}$ , and the individual  $\overline{\text{OEBO}}$  thru  $\overline{\text{OEBO}}$  byte control pins.

Diagnostics are performed on the EDACs by controls and internal paths that allow the user to read the contents of the DB and CB input latches. These will determine if the failure occurred in memory or in the EDAC.

#### **Features**

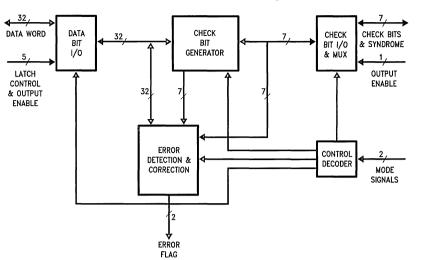
- Detects and corrects single-bit errors
- Detects and flags double-bit errors
- Built-in diagnostic capability
- Fast write and read cycle processing times
- Byte-write capability ... DP8402A and DP8403
- Fully pin and function compatible with TI's SN74ALS632A thru SN74ALS635 series

#### System Environment



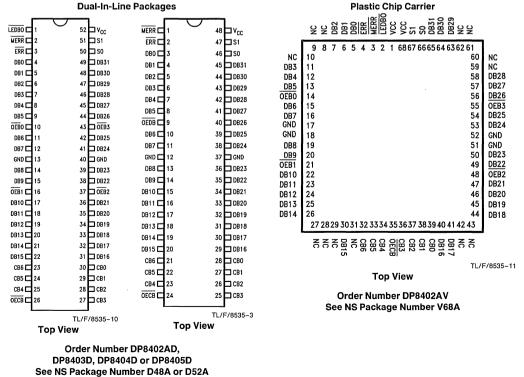
TL/F/8535-1

#### **Simplified Functional Block and Connection Diagrams**



Device Package **Byte-Write** Output DP8402A 52-pin **TRI-STATE®** yes DP8403 52-pin Open-Collector yes DP8404 48-pin TRI-STATE no DP8405 48-pin Open-Collector no

**Dual-In-Line Packages** 



TL/F/8535-2

|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | De       | fl         |                |                 | 1998-187       |                |                 | - 0040    | <b></b> |  |  |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------------|----------------|-----------------|----------------|----------------|-----------------|-----------|---------|--|--|
| Mode                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | -        |            |                |                 |                | PCC Pin I      | Jetinition      | S DP840   |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                | pin 1          | V <sub>CC</sub> | pin 35    |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                |                |                 | 36        |         |  |  |
| 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | L        | L WHI      | IE             |                 | ord and output | 3              | MERR            | 37        | CB2     |  |  |
| +                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |          |            |                |                 | ie data worde  | 4              | ERR             | 38        | CB1     |  |  |
| •                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | L        |            | anosnos        |                 |                | 5              | DB0             | 39        | CB0     |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                | 6              | DB1             | 40        | DB16    |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                | error flags.    | oupurrailu     | 7              | DB2             | 41        | DB17    |  |  |
| 2                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | н        | L REA      | D & FLAG       | Input dataw     | ord and output | 8              | NC              | 42        | NC      |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                | error flags     | ·              | 9              | NC              | 43        | NC      |  |  |
| 3                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Н        | H COF      | RECT           | Latched inp     | out data and   | 10             | NC              | 44        | DB18    |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                | checkword       | /output        | 11             | DB3             | 45        | DB19    |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                | syndrome o      | ode            |                |                 |           |         |  |  |
| <b>D'</b> D                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | <i>.</i> |            |                |                 |                |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | etin     |            | -              |                 |                |                |                 |           |         |  |  |
| S0, S1                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |          |            |                | de, see prec    | eding          |                | 1               |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                |                |                 |           |         |  |  |
| CB0 thru                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | CB6      |            |                |                 |                |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 | auring         |                |                 |           |         |  |  |
| OEB0 th                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |          |            |                |                 | Vhon bigh      |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | u        |            |                |                 |                | = -            |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | Δ        |            |                |                 |                |                |                 |           |         |  |  |
| •                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Λ,       |            |                |                 |                | 23             | DB11            | 57        | DB27    |  |  |
| D1 0400)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |          |            |                |                 |                | 24             | DB12            | 58        | DB28    |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                | 25             | DB13            | 59        | NC      |  |  |
| LEDBO                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |          |            |                |                 | When high      | 26             | DB14            | 60        | NC      |  |  |
| (DP8402                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | A,       | it inhibit | s input to the | e Latch. Oper   | rates on all   | 27             | NC              | 61        | NC      |  |  |
| DP8403)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |          |            |                |                 |                | 28             | NC              | 62        | NC      |  |  |
| OEDB                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |          | TRI-ST     | ATE control 1  | for the data I. | /O port.       | 29             | NC              | 63        | DB29    |  |  |
| •                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | ,        |            |                | uffers are at   |                | 30             | DB15            | 64        | DB30    |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                |                |                 |           |         |  |  |
| OECB                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |          |            |                |                 |                |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            | e output buffe | ers are in TRI  | -STATE         |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                |                |                 |           |         |  |  |
| ERR                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |          |            |                |                 | icates at      | 34             | 064 1           | 00        | VCC     |  |  |
| MEDD                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |          |            |                |                 | diaataa        |                |                 |           |         |  |  |
| MENN                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |          |            |                |                 | luicates       |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            | nore entris p  | resent.         |                |                |                 |           |         |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |          |            |                |                 |                |                |                 |           |         |  |  |
| MODE PIN NAME DESCRIPTION<br>St S0OPERATION<br>MODEpin 1VCC<br>LEDEDpin 35OECB0LWRTE<br>L WRTE<br>AND ADDEInput dataword and output<br>checkword3MERR<br>437CB21LHDIAGNOSTICS<br>against latched3MERR<br>437CB21LHDIAGNOSTICS<br>against latched5DB039CB02HLREAD & FLAG<br>error flags.Input dataword and output<br>error flags.7DB241DB172HLREAD & FLAG<br>error flags.Input dataword and output<br>error flags.8NC42NC3HHCORRECT<br>error flags.Latched input data and<br>checkword/output<br>corrected data and<br>syndrome code10NC44DB192DEDefinitions14OEED48OEED3Mode Definitions14OEED48OEED3DB17Control of EDAC mode, see preceding<br>Mode Definitions17GND51GND3DB17Control of T/bit checkword. Also output18GND52GND4DEB17Control of T/bit checkword. Also output18GND52GND4DEB17Control of T/bit checkword. Also output18GND52GND5OEE3Output buffer erable. When high,<br>OEE320DB854DB256Dataword output Latch enable. When high,<br>OEE32 |          |            |                |                 |                |                |                 |           |         |  |  |
| •                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |          |            |                | Data I/O        | OEBn or        | DP8402A, DP840 |                 | O Control | -       |  |  |
| Write                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |          |            | LL             | Input           | Н              | х              |                 | † L       | нн      |  |  |

†See Table II for details on check bit generation.

#### **Memory Write Cycle Details**

During a memory write cycle, the check bits (CB0 thru CB6) are generated internally in the EDAC by seven 16-input parity generators using the 32-bit data word as defined in Table

2. These seven check bits are stored in memory along with the original 32-bit data word. This 32-bit word will later be used in the memory read cycle for error detection and correction.

The seven check bits are parity bits derived from the matrix of data bits as indicated by "X" for each bit.

Check bits 0, 1, 2 are odd parity or the exclusive NORing of the "X"ed bits for the particular check bit. Check bits 3, 4, 5, 6 are even parity or the exclusive ORing of the "X"ed bits for the particular check bit.

#### Memory Read Cycle (Error Detection & Correction Details)

During a memory read cycle, the 7-bit check word is retrieved along with the actual data. In order to be able to determine whether the data from the memory is acceptable to use as presented on the bus, the error flags must be tested to determine if they are at the high level.

The first case in Table III represents the normal, no-error conditions. The EDAC presents highs on both flags. The

next two cases of single-bit errors give a high on  $\overline{\text{MERR}}$  and a low on  $\overline{\text{ERR}}$ , which is the signal for a correctable error, and the EDAC should be sent through the correction cycle. The last three cases of double-bit errors will cause the EDAC to signal lows on both  $\overline{\text{ERR}}$  and  $\overline{\text{MERR}}$ , which is the interrupt indication for the CPU.

| Total Numb       | er of Errors     | Erro | r Flags | Data Correction |  |  |  |  |  |  |  |  |  |
|------------------|------------------|------|---------|-----------------|--|--|--|--|--|--|--|--|--|
| 32-Bit Data Word | 7-Bit Check Word | ERR  | MERR    | Data Concetion  |  |  |  |  |  |  |  |  |  |
| 0                | 0                | Н    | н       | Not applicable  |  |  |  |  |  |  |  |  |  |
| 1                | 0                | L    | н       | Correction      |  |  |  |  |  |  |  |  |  |
| 0                | 1                | L    | н       | Correction      |  |  |  |  |  |  |  |  |  |
| 1                | 1                | L    | L       | Interrupt       |  |  |  |  |  |  |  |  |  |
| 2                | 0                | L    | L       | Interrupt       |  |  |  |  |  |  |  |  |  |
| 0                | 2                | L L  | L       | Interrupt       |  |  |  |  |  |  |  |  |  |

The DP8402 check bit syndrome matrix can be seen in TA-BLE II. The horizontal rows of this matrix generate the check bits by selecting different combinations of data bits, indicated by "X"s in the matrix, and generating parity from them. For instance, parity check bit "0" is generated by EXCLUSIVE NORing the following data bits together; 31, 29, 28, 26, 21, 19, 18, 17, 14, 11, 9, 8, 7, 6, 4, and 0. For example, the data word "0000001H" would generate the check bits CB6-0 = 48H (Check bits 0, 1, 2 are odd parity and check bits 3, 4, 5, 6 are even parity).

During a WRITE operation (mode 0) the data enters the DP8402 and check bits are generated at the check bit input/output port. Both the data word and the check bits are then written to memory. During a READ operation (mode 2, error detection) the data and check bits that were stored in memory, now possibly in error, are input through the data and check bit I/O ports. New check bits are internally generated from the data word. These new check bits are then compared, by an EXCLU-SIVE NOR operation, with the original check bits that were stored in memory. The EXCLUSIVE NOR of the original check bits, that were stored in memory, with the new check bits is called the syndrome word. If the original check bits are the same as the new check bits, a no error condition, then a syndrome word of all ones is produced and both error flags (ERR and MERR) will be high. The DP8402 matrix encodes errors as follows:

| Memory<br>Cycle | EDAC<br>Function                            | Cor<br>S1 | ntrol<br>S0 | Data I/O                         | DB Control<br>OEBn or<br>OEDB | DB Output Latch<br>DP8402A, DP8403<br>LEDBO | Check I/O                      | CB<br>Control<br>OECB | Error Flags<br>ERR MERR |  |  |
|-----------------|---------------------------------------------|-----------|-------------|----------------------------------|-------------------------------|---------------------------------------------|--------------------------------|-----------------------|-------------------------|--|--|
| Read            | Read & flag                                 | н         | L           | Input                            | Н                             | Х                                           | Input                          | Н                     | Enabled†                |  |  |
| Read            | Latch input<br>data and check<br>bits       | н         | н           | Input<br>data<br>latched         | н                             | L                                           | Input<br>check word<br>latched | Н                     | Enabled†                |  |  |
| Read            | Output<br>corrected data<br>& syndrome bits | н         | Н           | Output<br>corrected<br>data word | L                             | x                                           | Output<br>syndrome<br>bits‡    | L                     | Enabled†                |  |  |

#### TABLE IV. Read, Flag, and Correct Function



#### Memory Read Cycle (Error Detection & Correction Details) (Continued)

1) Single data bit errors cause 3 or 5 bits in the syndrome word to go low. The columns of the check bit syndrome matrix (TABLE II) are the syndrome words for all single bit data errors in the 32 bit word (also see TABLE V). The data bit in error corresponds to the column in the check bit syndrome matrix that matches the syndrome word. For instance, the syndrome word indicating that data bit 31 is in error would be (CB6-CB0) = "0001010", see the column for data bit 31 in TABLE II, or see TABLE V. During mode 3 (S0 = S1 = 1) the syndrome word is decoded, during single data bit errors, and used to invert the bit in error thus correcting the data word. The corrected word is made available on the data I/O port (DB0 thru DB31), the check word I/O port (CB0 thru CB6) presents the 7-bit syndrome error code. This syndrome error code can be used to locate the bad memory chip.

- 2) A single check bit error will cause that particular check bit to go low in the syndrome word.
- 3) A double bit error will cause an even number of bits in the syndrome word to go low. The syndrome word will then be the EXCLUSIVE NOR of the two individual syndrome words corresponding to the 2 bits in error. The two-bit error is not correctable since the parity tree can only identify single bit errors.

If any of the bits in the syndrome word are low the "ERR" flag goes low. The "MERR" (dual error) flag goes low during any double bit error conditions. (See Table III).

Three or more simultaneous bit errors can cause the EDAC to believe that no error, a correctable error, or an uncorrectable error has occurred and will produce erroneous results in all three cases. It should be noted that the gross-error conditions of all lows and all highs will be detected.

| TABLE | V. Syndrome | Decoding |
|-------|-------------|----------|
|-------|-------------|----------|

| Syndrome Bits               | Error |   | Sy | ndr | om | eВ | lits |   | Error | Γ    | s   | yn | dre | om | e E | Bits |   | Error |   | Syr | ndr | om | e E | lits |   | Error |
|-----------------------------|-------|---|----|-----|----|----|------|---|-------|------|-----|----|-----|----|-----|------|---|-------|---|-----|-----|----|-----|------|---|-------|
| 6543210                     |       | 6 | 5  | 4   | 3  | 2  | 1    | 0 | LIIOI | 6    | ; ; | 5  | 4   | 3  | 2   | 1    | 0 | LIIO  | 6 | 5   | 4   | 3  | 2   | 1    | 0 | LIIO  |
| LLLLLL                      | unc   | L | Н  | L   | L  | L  | L    | L | 2-bit | H    |     |    | L   | L  | L   | L    | Г | 2-bit | н | Н   | L   | L  | L   | L    | Г | unc   |
| LLLLLH                      | 2-bit | L | н  | L   | L  | L  | L    | Н | unc   | H    | 1 1 | L  | _   |    | L   | L    | н | unc   | Н | Н   | L   | L  | L   | L    | Н | 2-bit |
|                             | 2-bit | L | н  |     |    | L  |      | L | DB7   | H    |     |    |     |    | L   |      | L | unc   | Н |     | L   |    | L   |      | L | 2-bit |
|                             | unc   | L | Н  | L   | L  | L  | Н    | Н | 2-bit | н    | 1 1 | _  | L   | L  | L   | Н    | Н | 2-bit | Н | Н   | L   | L  | L   | Н    | Н | DB23  |
| LLLLHLL                     | 2-bit | L | н  | L   | L  | Н  | L    | L | DB6   | H    | 11  |    |     | L  | Н   | L    | L | unc   | н | Н   | L   | L  | Н   | L    | L | 2-bit |
| LLLLHLH                     | unc   | L | Н  | L   | L  | Н  | L    | н | 2-bit | H    | 11  |    | L.  | L  | н   | L    | Н | 2-bit | Н | н   | L   | L  | Н   | L    | Н | DB22  |
|                             | unc   | L | н  | L   | L  | н  | Н    | L | 2-bit | H    |     | L  |     |    | Н   |      | L | 2-bit | Н |     |     |    | Н   |      | L | DB21  |
| ГГГГННН                     | 2-bit | L | Н  | L   | L  | Н  | Н    | Н | DB5   | Н    | 1 1 | L  | L   | L  | Н   | н    | Н | unc   | Н | Н   | L   | L  | Н   | Н    | Н | 2-bit |
| LLLHLLL                     | 2-bit | L | н  | L   | н  | L  | L    | L | DB4   | _ H  | 1 1 | L  | L   | Н  | L   | L    | L | unc   | н | Н   | L   | н  | L   | L    | L | 2-bit |
| LLLHLLH                     | unc   | L | Н  | L   | н  | L  | L    | Н | 2-bit | H    | 1 1 | L  | L   | Н  | L   | L    | Н | 2-bit | Н | н   | L   | Н  | L   | L    | Н | DB20  |
|                             | DB31  | L | Н  | L   | н  | L  | н    | L | 2-bit | H    | 1 1 | L  | L   | Н  | L   | Н    | L | 2-bit | Н | н   | L   | Н  | L   | Н    | L | DB19  |
| LLLHLHH                     | 2-bit | L | Н  | L   | Н  | L  | н    | Н | DB3   | H    |     | L  | L   | Н  | L   | Н    | Н | DB15  | Н | Н   | L   | Н  | L   | Н    | Н | 2-bit |
| LLLHHLL                     | unc   | L | н  | L   | Н  | Н  | L    | L | 2-bit | H    | 1 1 | L  | L   | н  | н   | L    | L | 2-bit | н | Н   | L   | н  | н   | L    | L | DB18  |
| LLLHHLH                     | 2-bit | L | Н  | L   | н  | н  | L    | Н | DB2   | _ ⊢  | 1 1 | L  | L   | Н  | Н   | L    | Н | unc   | Н | н   | L   | Н  | н   | L    | Н | 2-bit |
| LLLHHHL                     | 2-bit | L | Н  | L   | Н  | н  | Н    | L | unc   | H    | 1 1 | L  | L   | н  | н   | н    | L | DB14  | Н | н   | L   | н  | Н   | н    | L | 2-bit |
| ГГГНННН                     | DB30  | L | н  | L   | Н  | Н  | н    | н | 2-bit | F    |     | L  | L   | Н  | н   | Н    | Н | 2-bit | Н | Н   | L   | Н  | Н   | Н    | Н | CB4   |
| Ц Ц Ц Ц Ц Ц Ц               | 2-bit | L | н  | Н   | L  | L  | L    | L | DB0   | F    | 1 1 | LI | Н   | L  | L   | L    | L | unc   | н | н   | н   | L  | L   | L    | L | 2-bit |
| LLHLLLH                     | unc   | L | Н  | н   | L  | L  | L    | Н | 2-bit | _  ⊦ | 1 1 | LI | Н   | L  | L   | L    | Н | 2-bit | Н | н   | н   | L  | L   | L    | Н | DB16  |
|                             | DB29  | L | Н  | н   | L  | L  | н    | L | 2-bit | H    |     | LI | Н   | L  | L   | н    | L | 2-bit | Н | н   | н   | L  | L   | Н    | L | unc   |
| LLHLLHH                     | 2-bit | L | н  | Н   | L  | L  | н    | Н | unc   | ۲    | 1 1 | LI | н   | L  | L   | н    | н | DB13  | н | Н   | Н   | L  | L   | Н    | Н | 2-bit |
| LLHLHLL                     | DB28  | L | н  | Н   | L  | н  | L    | L | 2-bit | F    | 1 1 | LI | н   | L  | н   | L    | L | 2-bit | н | н   | н   | L  | н   | L    | L | DB17  |
| LLHLHLH                     | 2-bit | L | Н  | н   | L  | н  | L    | Н | DB1   | ۱ŀ   | 1 1 | LI | Н   | L  | н   | L    | Н | DB12  | Н | н   | н   | L  | н   | L    | Н | 2-bit |
| LLHLHHL                     | 2-bit | L | Н  | н   | L  | н  | н    | L | unc   | H    | 1 1 | LI | Н   | L  | Н   | н    | L | DB11  | Н | н   | н   | L  | н   | Н    | L | 2-bit |
| LLHLHHH                     | DB27  | L | Н  | Н   | L  | Н  | Н    | Н | 2-bit | ۲    | 1 1 |    | H   | L  | Н   | н    | Н | 2-bit | н | Н   | Н   | L  | Н   | н    | н | CB3   |
| LLHHLLL                     | DB26  | L | н  | н   | н  | L  | L    | L | 2-bit | F    | 1   | LI | н   | н  | L   | L    | L | 2-bit | н | н   | н   | н  | L   | L    | L | unc   |
| <b>LLННLLН</b>              | 2-bit | L | н  | н   | н  | L  | L    | Н | unc   | H    | 1 1 | LI | Н   | Н  | L   | L    | Н | DB10  | Н | н   | н   | н  | L   | L    | Н | 2-bit |
| L L H H L H L               | 2-bit | L | Н  | н   | н  | L  | Н    | L | unc   | F    | 1 1 | LI | Н   | Н  | L   | н    | L | DB9   | Н | н   | Н   | Н  | L   | Н    | L | 2-bit |
| LLHHLHH                     | DB25  | L | н  | Н   | Н  | L  | Н    | Н | 2-bit | F    | 1 1 | L  | Н   | Н  | L   | Н    | Н | 2-bit | н | Н   | Н   | Н  | L   | Н    | Н | CB2   |
| LLHHHLL                     | 2-bit | L | н  | Н   | Н  | н  | L    | L | unc   | ۲    | 1 1 | LI | Н   | н  | Н   | L    | L | DB8   | н | н   | н   | н  | Н   | L    | L | 2-bit |
| LLHHHLH                     | DB24  | L | н  | н   | н  | н  | L    | н | 2-bit | F    | 1 1 | LI | н   | Н  | н   | L    | н | 2-bit | н | Н   | Н   | н  | н   | L    | Н | CB1   |
| L L Н Н Н Н L               | unc   | L | н  | Н   | н  | н  | Н    | L | 2-bit | H    | 1 1 | L  | н   | н  | Н   | н    | L | 2-bit | н | н   | Н   | н  | Н   | н    | L | CB0   |
| LLННННН                     | 2-bit | L | н  | Н   | Н  | Н  | Н    | н | CB6   | ⊦∣   | 1   | L  | Н   | н  | Н   | Н    | н | CB5   | н | Н   | Н   | Н  | Н   | Н    | Н | none  |
| CB X = error in check bit 2 | x     |   |    |     |    |    |      |   |       | -    |     |    |     |    |     |      |   |       |   |     |     |    |     |      |   |       |
| DB Y = error in data bit Y  |       |   |    |     |    |    |      |   |       |      |     |    |     |    |     |      |   |       |   |     |     |    |     |      |   |       |

2-bit = double-bit error

unc = uncorrectable multibit error

| -               | DBOUTPUT                           |            |            |                             |       |                             |                                |               |                |         |  |  |  |
|-----------------|------------------------------------|------------|------------|-----------------------------|-------|-----------------------------|--------------------------------|---------------|----------------|---------|--|--|--|
| MEMORY<br>CYCLE | EDAC FUNCTION                      | CONT<br>S1 | FROL<br>S0 | BYTEn†                      | 0EBn† | DB OUTPUT<br>LATCH<br>LEDBO | СНЕСК І/О                      | CB<br>CONTROL | ERROF<br>ERR I | R FLAG  |  |  |  |
| Read            | Read & Flag                        | н          | L          | Input                       | н     | Х                           | Input                          | Н             | Enabled        |         |  |  |  |
| Read            | Latch input data<br>& check bits   | н          | н          | Input<br>data<br>latched    | н     | L                           | Input<br>check word<br>latched | Н             | Ena            | Enabled |  |  |  |
|                 | Latch corrected                    |            |            | Output                      |       |                             | Hi-Z                           | Н             |                |         |  |  |  |
| Read            | data word into<br>output latch     | Н          | Н          | data<br>word<br>latched     | н     | Н                           | Output<br>Syndrome<br>bits     | L             | Enabled        |         |  |  |  |
| Modify          | Modify appropriate byte or bytes & | 1          | L          | Input<br>modified<br>BYTE0  | Н     | н                           | Output                         | L             | Н              | н       |  |  |  |
| /write          | generate new<br>check word         | L          | L          | Ouput<br>unchanged<br>BYTE0 | L     |                             | check word                     | L             | 11             | п       |  |  |  |

TOEB0 controls DB0-DB7 (BYTE0), OEB1 controls DB8-DB15 (BYTE1), OEB2 controls DB16-DB23 (BYTE2), OEB3 controls DB24-DB31 (BYTE3).

#### Read-Modify-Write (Byte Control) Operations

The DP8402A and DP8403 devices are capable of bytewrite operations. The 39-bit word from memory must first be latched into the DB and CB input latches. This is easily accomplished by switching from the read and flag mode (S1 = H, SO = L) to the latch input mode (S1 = H, SO = H). The EDAC will then make any corrections, if necessary, to the data word and place it at the input of the output data latch. This data word must then be latched into the output data latch by taking LEDBO from a low to a high.

Byte control can now be employed on the data word through the  $\overline{OEB0}$  through  $\overline{OEB3}$  controls.  $\overline{OEB0}$  controls DB0–DB7 (byte 0),  $\overline{OEB1}$  controls DB8–DB15 (byte 1),  $\overline{OEB2}$  controls DB16–DB23 (byte 2), and  $\overline{OEB3}$  controls DB24–DB31 (byte 3). Placing a high on the byte control will disable the output and the user can modify the byte. If a low is placed on the byte control, then the original byte is allowed to pass onto the data bus unchanged. If the original data word is altered through byte control, a new check word must be generated before it is written back into memory. This is easily accomplished by taking control S1 and S0 low. Table VI lists the read-modify-write functions.

#### **Diagnostic Operations**

The DP8402A thru DP8405 are capable of diagnostics that allow the user to determine whether the EDAC or the memory is failing. The diagnostic function tables will help the user to see the possibilities for diagnostic control.

In the diagnostic mode (S1 = L, S0 = H), the checkword is latched into the input latch while the data input remains transparent. This lets the user apply various data words against a fixed known checkword. If the user applies a diagnostic data word with an error in any bit location, the ERR flag should be low. If a diagnostic data word with two errors in any bit location is applied, the MERR flag should be low. After the checkword is latched into the input latch, it can be verified by taking OECB low. This outputs the latched checkword. With the DP8402A and DP8403, the diagnostic data word can be latched into the output data latch and verified. It should be noted that the DP8404 and DP8405 do not have this pass-through capability because they do not contain an output data latch. By changing from the diagnostic mode (S1 = L, S0 = H) to the correction mode (S1 = H, S0 = H), the user can verify that the EDAC will correct the diagnostic data word. Also, the syndrome bits can be produced to verify that the EDAC pinpoints the error location. Table VII DP8402A and DP8403 and Table VIII DP8404 and DP8405 list the diagnostic functions.



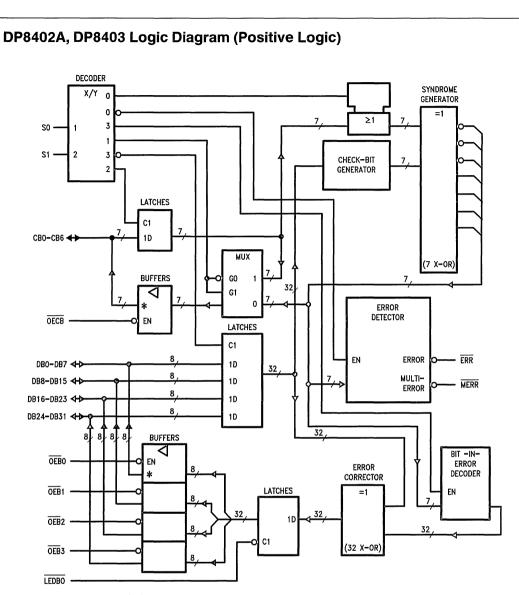
|                                                                            |           |            | TABLE VII. DP                     | 8402A, DP84                | 03 Diagnostic               | Function                       |                       |              |                 |
|----------------------------------------------------------------------------|-----------|------------|-----------------------------------|----------------------------|-----------------------------|--------------------------------|-----------------------|--------------|-----------------|
| EDAC FUNCTION                                                              | CON<br>S1 | TROL<br>S0 | DATA I/O                          | DB BYTE<br>CONTROL<br>OEBn | DB OUTPUT<br>LATCH<br>LEDBO | CHECK I/O                      | CB<br>CONTROL<br>OECB | ERROF<br>ERR | R FLAGS<br>MERR |
| Read & flag                                                                | Н         | L          | Input correct<br>data word        | н                          | x                           | Input correct check bits       | н                     | Н            | Н               |
| Latch input check<br>word while data<br>input latch remains<br>transparent | L         | н          | Input<br>diagnostic<br>data word† | Н                          | L                           | Input<br>check bits<br>latched | Н                     | Ena          | abled           |
| Latch diagnostic data word into                                            | L         | Н          | Input<br>diagnostic               | н                          | н                           | Output latched check bits      | L                     | Ena          | abled           |
| output latch                                                               |           |            | data word†                        |                            |                             | Hi-Z                           | н                     |              |                 |
| Latch diagnostic<br>data word into<br>input latch                          | Н         | н          | Input<br>diagnostic<br>data word  | Н                          | н                           | Output<br>syndrome<br>bits     | L                     | En           | abled           |
| inputiation                                                                |           |            | latched                           |                            |                             | Hi-Z                           | н                     |              |                 |
| Output diagnostic data word &                                              | н         | н          | Output<br>diagnostic              | L                          | н                           | Output<br>syndrome<br>bits     | L                     | En           | abled           |
| syndrome bits                                                              |           |            | data word                         |                            |                             | Hi-Z                           | н                     |              |                 |
| Output corrected<br>diagnostic data<br>word & output                       | Н         | н          | Output<br>corrected<br>diagnostic | corrected                  |                             | Output<br>syndrome<br>bits     | L                     | En           | abled           |
| syndrome bits                                                              |           |            | data word                         |                            |                             | Hi-Z                           | н                     | 1            |                 |

†Diagnostic data is a data word with an error in one bit location except when testing the MERR error flag. In this case, the diagnostic data word will contain errors in two bit locations.

#### TABLE VIII. DP8404, DP8405 Diagnostic Function

|                                                                            |           |            |                                   | ., <u>.</u> |                                |                    |              |                 |
|----------------------------------------------------------------------------|-----------|------------|-----------------------------------|-------------|--------------------------------|--------------------|--------------|-----------------|
| EDAC FUNCTION                                                              | CON<br>S1 | TROL<br>S0 | DATA I/O                          | DB CONTROL  | CHECK I/O                      | DB CONTROL<br>OECB | ERROF<br>ERR | R FLAGS<br>MERR |
| Read & flag                                                                | н         | L          | Input correct<br>data word        | H           | Input correct<br>check bits    | Н                  | н            | н               |
| Latch input check<br>bits while data<br>input latch remains<br>transparent | L         | н          | Input<br>diagnostic<br>data word† | Н           | Input<br>check bits<br>latched | Н                  | Ena          | abled           |
| Output input<br>check bits                                                 | L         | н          | Input<br>diagnostic<br>data word† | н           | Output input<br>check bits     | L                  | Ena          | abled           |
| Latch diagnostic data into                                                 | н         | н          | Input<br>diagnostic               | Н           | Output<br>syndrome bits        | L                  |              | abled           |
| input latch                                                                |           |            | data word<br>latched              |             | Hi-Z                           | Н                  | Lin          |                 |
| Output corrected diagnostic                                                | н         | Н          | Output corrected diagnostic       | L           | Output<br>syndrome bits        | L                  | Ena          | abled           |
| data word                                                                  |           |            | data word                         |             | Hi-Z                           | н                  |              |                 |

†Diagnostic data is a data word with an error in one bit location except when testing the MERR error flag. In this case, the diagnostic data word will contain errors in two bit locations.

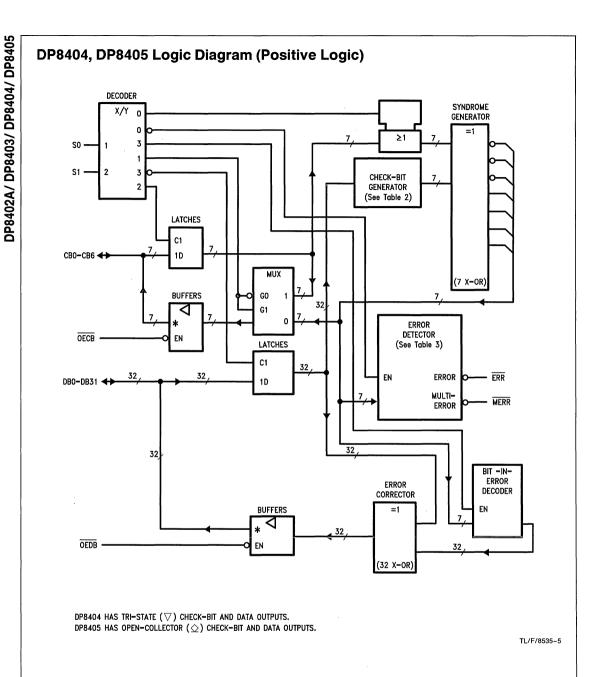


DP8402A HAS TRI-STATE (  $\bigtriangledown$  ) CHECK-BIT AND DATA OUTPUTS. DP8403 HAS OPEN-COLLECTOR (  $\bigcirc$  ) CHECK-BIT AND DATA OUTPUTS.

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If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Over Operating Free-Air Temperature Range (unless otherwise noted)

| Supply Voltage, V <sub>CC</sub> (See Note 1) | 7V   | Operating Free-Air |
|----------------------------------------------|------|--------------------|
| Input Voltage: CB and DB                     | 5.5V |                    |
| All Others                                   | 7V   | Storage Temperate  |

| Operating Free-Air Temperature | e: Military -55°C to +125°C |
|--------------------------------|-----------------------------|
|                                | Commercial 0° to +70°C      |
| Storage Temperature Range      | -65°C to +150°C             |

#### **Recommended Operating Conditions**

| Symbol            | Parameter                                        | Conditions                                                       |     | Militar | y    | Co  | omme | rcial | Units   |
|-------------------|--------------------------------------------------|------------------------------------------------------------------|-----|---------|------|-----|------|-------|---------|
| Cymbol            | ranameter                                        |                                                                  | Min | Тур     | Max  | Min | Тур  | Max   | onita   |
| V <sub>CC</sub>   | Supply Voltage                                   |                                                                  | 4.5 | 5       | 5.5  | 4.5 | 5    | 5.5   | v       |
| VIH               | High-Level Input Voltage                         |                                                                  | 2   |         |      | 2   |      |       | V       |
| VIL               | Low-Level Input Voltage                          |                                                                  |     |         | 0.8  |     |      | 0.8   | V       |
| ЮН                | High-Level Output Current                        | ERR Or MERR                                                      |     |         | -0.4 |     |      | -0.4  | mA      |
| юн                | righ Lover output ourient                        | DB Or CB DP8402A, DP8404                                         |     |         | -1   |     |      | -2.6  |         |
| lol               | Low-Level Output Current                         | ERR Or MERR                                                      |     |         | 4    |     |      | 8     | mA      |
| ·OL               |                                                  | DB or CB                                                         |     |         | 12   |     |      | 24    | 11.00 ( |
| t <sub>w</sub>    | Pulse Duration                                   | LEDBO Low                                                        | 25  |         |      | 25  |      |       | ns      |
|                   |                                                  | (1) Data And Check Word Before S0 $\uparrow$ (S1 = H)            | 15  |         |      | 10  |      |       |         |
|                   |                                                  | (2) SO High Before LEDBO ↑ (S1 = H)†                             | 45  |         |      | 45  |      |       |         |
|                   |                                                  | (3) LEDBO High Before The Earlier<br>of S0↓ or S1↓†              | 0   |         |      | 0   |      |       |         |
| t <sub>su</sub>   | Setup Time                                       | (4) $\overline{\text{LEDBO}}$ High Before S1 $\uparrow$ (S0 = H) | 0   |         |      | 0   |      |       | ns      |
|                   |                                                  | (5) Diagnostic Data Word Before S1 $\uparrow$<br>(S0 = H)        | 15  |         |      | 10  |      |       |         |
|                   |                                                  | (6) Diagnostic Check Word Before<br>The Later Of S1↓ or S0↑      | 15  |         |      | 10  |      |       |         |
|                   |                                                  | (7) Diagnostic Data Word Before<br>LEDBO ↑ (S1 = L and S0 = H)‡  | 25  |         |      | 20  |      |       |         |
|                   |                                                  | (8) Read-Mode, S0 Low And S1 High                                | 35  |         |      | 30  |      |       |         |
|                   |                                                  | (9) Data And Check Word After S0 $\uparrow$ (S1 = H)             | 20  |         |      | 15  |      |       |         |
| t <sub>h</sub>    | Hold Time                                        | (10) Data Word After S1 $\uparrow$ (S0 = H)                      | 20  |         |      | 15  |      |       |         |
|                   | (11) Check Word After The Later<br>of S1↓ or S0↑ | 20                                                               |     |         | 15   |     |      | ns    |         |
|                   |                                                  | (12) Diagnostic Data Word After<br>IEDBO↑ (S1 = L And S0 = H)‡   | 0   |         |      | 0   |      |       |         |
| t <sub>corr</sub> | Correction Time (see Figure                      | 9 1)*                                                            | 65  |         |      | 58  |      |       | ns      |
| TA                | Operating Free-Air Temper                        | ature                                                            | -55 |         | 125  | 0   |      | 70    | °C      |

\*This specification may be interpreted as the maximum delay to guarantee valid corrected data at the output and includes the t<sub>su</sub> setup delay.

 $\ensuremath{^\dagger}\xspace{These}$  times ensure that corrected data is saved in the output data latch.

 $\ddagger\ensuremath{\mathsf{These}}$  times ensure that the diagnostic data word is saved in the output data latch.

## DP8402A, DP8404 Electrical Characteristics Over Recommended Operating Free-Air Temperature Range (unless otherwise noted)

| <b>A</b>                    |                                         |                                           | 1                  | Military |       | Co                 | mmerci | al   |       |
|-----------------------------|-----------------------------------------|-------------------------------------------|--------------------|----------|-------|--------------------|--------|------|-------|
| Symbol                      | Parameter                               | Test Conditions                           | Min                | Typ†     | Max   | Min                | Тур†   | Max  | Units |
| VIK                         |                                         | $V_{CC} = 4.5V, I_I = -18 \text{ mA}$     |                    |          | - 1.5 |                    |        | -1.5 | V     |
|                             | All outputs                             | $V_{CC}=$ 4.5V to 5.5V, $I_{OH}=-$ 0.4 mA | V <sub>CC</sub> -2 |          |       | V <sub>CC</sub> -2 |        |      |       |
| V <sub>OH</sub>             | DB or CB                                | $V_{CC} = 4.5V, I_{OH} = -1 \text{ mA}$   | 2.4                | 3.3      |       |                    |        |      | v     |
|                             | DEDICE                                  | $V_{CC} = 4.5V, I_{OH} = -2.6 \text{ mA}$ |                    |          |       | 2.4                | 3.2    |      |       |
|                             | ERR or MERR                             | $V_{CC} = 4.5V$ , $I_{OL} = 4$ mA         |                    | 0.25     | 0.4   |                    | 0.25   | 0.4  |       |
| V <sub>OL</sub><br>DB or CB | $V_{CC} = 4.5V$ , $I_{OL} = 8$ mA       |                                           |                    |          |       | 0.35               | 0.5    | v    |       |
|                             | DB at CB                                | $V_{CC} = 4.5V, I_{OL} = 12 \text{ mA}$   |                    | 0.25     | 0.4   |                    | 0.25   | 0.4  | v     |
|                             | $V_{CC} = 4.5V, I_{OL} = 24 \text{ mA}$ |                                           |                    |          |       | 0.35               | 0.5    |      |       |
| ,                           | S0 or S1                                | $V_{CC} = 5.5V, V_1 = 7V$                 |                    |          | 0.1   |                    |        | 0.1  |       |
| lj –                        | All others                              | $V_{\rm CC} = 5.5 V, V_1 = 5.5 V$         |                    |          | 0.1   |                    |        | 0.1  | mA    |
|                             | S0 or S1                                |                                           |                    |          | 20    |                    |        | 20   |       |
| lΉ                          | All others‡                             | $V_{\rm CC} = 5.5 V, V_{\rm I} = 2.7 V$   |                    |          | 20    |                    |        | 20   | μA    |
|                             | S0 or S1                                |                                           |                    |          | -0.4  |                    |        | -0.4 |       |
| կլ                          | All others‡                             | $V_{CC} = 5.5V, V_{I} = 0.4V$             |                    |          | -0.1  |                    |        | -0.1 | mA    |
| lO§                         |                                         | $V_{\rm CC} = 5.5 V, V_{\rm O} = 2.25 V$  | -30                |          | -112  | -30                |        | -112 | mA    |
| Icc                         |                                         | V <sub>CC</sub> = 5.5V, (See Note 1)      |                    | 150      | 250   |                    | 150    | 250  | mA    |

#### **DP8403, DP8405 Electrical Characteristics**

Over Recommended Operating Free-Air Temperature Range (unless otherwise noted)

| 0                |                                         |                                             |                    | Military |      | Co                 | mmercia | al   |       |
|------------------|-----------------------------------------|---------------------------------------------|--------------------|----------|------|--------------------|---------|------|-------|
| Symbol           | Parameter                               | Test Conditions                             | Min                | Typ†     | Max  | Min                | Тур†    | Max  | Units |
| VIK              |                                         | $V_{CC} = 4.5 V$ , $I_{I} = -18 \text{ mA}$ |                    |          | -1.5 |                    |         | -1.5 | ٧     |
| VOH              | ERR or MERR                             | $V_{CC}=$ 4.5V to 5.5V, $I_{OH}=-0.4$ mA    | V <sub>CC</sub> -2 |          |      | V <sub>CC</sub> -2 |         |      | ٧     |
| ЮН               | DB or CB                                | $V_{CC} = 4.5V, V_{OH} = 5.5V$              |                    |          | 0.1  |                    |         | 0.1  | mA    |
|                  |                                         | $V_{CC} = 4.5 V, I_{OL} = 4 \text{ mA}$     |                    | 0.25     | 0.4  |                    | 0.25    | 0.4  |       |
|                  | ERR or MERR                             | $V_{CC} = 4.5V, I_{OL} = 8 \text{ mA}$      |                    |          |      |                    | 0.35    | 0.5  | .,    |
| V <sub>OL</sub>  | $V_{CC} = 4.5V, I_{OL} = 12 \text{ mA}$ |                                             | 0.25               | 0.4      |      | 0.25               | 0.4     | V    |       |
| DB or CB         | DB of CB                                | $V_{CC} = 4.5V, I_{OL} = 24 \text{ mA}$     |                    |          |      |                    | 0.35    | 0.5  |       |
|                  | S0 or S1                                | $V_{CC} = 5.5V, V_{I} = 7V$                 |                    |          |      |                    |         |      |       |
| l)               | All others                              | $V_{CC} = 5.5V, V_1 = 5.5V$                 |                    |          |      |                    |         |      | mA    |
|                  | S0 or S1                                |                                             |                    |          |      |                    |         |      |       |
| Iн               | All others‡                             | $V_{CC} = 5.5V, V_{I} = 2.7V$               |                    |          |      |                    |         |      | μΑ    |
|                  | S0 or S1                                |                                             |                    |          |      |                    |         |      |       |
| Ι <sub>ΙL</sub>  | All others‡                             | $V_{CC} = 5.5V, V_{I} = 0.4V$               |                    |          |      |                    |         |      | mA    |
| ١ <sub>O</sub> ş | ERR or MERR                             | $V_{\rm CC} = 5.5 V, V_{\rm O} = 2.25 V$    | -30                |          | -112 | -30                |         | -112 | mA    |
| ICC              |                                         | V <sub>CC</sub> = 5.5V, (See Note 1)        |                    | 150      |      |                    | 150     |      | mA    |

†All typical values are at V\_{CC} = 5V, T\_A = +25^{\circ}C.

 $\ddagger For I/O ports (Q_A through Q_H), the parameters I_{IH} and I_{IL} include the off-state output current.$ 

\$The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

Note 1:  $I_{CC}$  is measured with S0 and S1 at 4.5V and all CB and DB pins grounded.

DP8402A/ DP8403/ DP8404/ DP8405

# DP8402A Switching Characteristics $V_{CC} = 4.5V$ to 5.5V, $C_L = 50$ pF, $T_A = Min$ to Max (unless otherwise noted)

-

| Symbol           | From                                | То       | Test Conditions                       | Mil | itary | Com | mercial | Units |
|------------------|-------------------------------------|----------|---------------------------------------|-----|-------|-----|---------|-------|
| Symbol           | (Input)                             | (Output) |                                       | Min | Max   | Min | Max     | 01113 |
| t <sub>pd</sub>  | DB and CB                           | ERR      | $S1 = H, S0 = L, R_L = 500\Omega$     | 10  | 43    | 10  | 40      | ns    |
| •pa              | DB                                  | ERR      | $S1 = L, S0 = H, R_L = 500\Omega$     | 10  | 43    | 10  | 40      |       |
| t <sub>pd</sub>  | DB and CB                           | MERR     | $S1 = H, S0 = L, R_L = 500\Omega$     | 15  | 67    | 15  | 55      | ns    |
| фa               | DB                                  | MERR     | $S1 = L, S0 = H, R_L = 500\Omega$     | 15  | 67    | 15  | 55      | 113   |
| t <sub>pd</sub>  | S0 $\downarrow$ and S1 $\downarrow$ | СВ       | $R1 = R2 = 500\Omega$                 | 10  | 60    | 10  | 48      | ns    |
| t <sub>pd</sub>  | DB                                  | CB       | $S1 = L, S0 = L, R1 = R2 = 500\Omega$ | 10  | 60    | 10  | 48      | ns    |
| t <sub>pd</sub>  | LEDB0                               | DB       | $S1 = X, S0 = H, R1 = R2 = 500\Omega$ | 7   | 35    | 7   | 30      | ns    |
| t <sub>pd</sub>  | S1 ↑                                | CB       | $S0 = H, R1 = R2 = 500\Omega$         | 10  | 60    | 10  | 50      | ns    |
| t <sub>en</sub>  | <u>OECB</u> ↓                       | СВ       | $S0 = H, S1 = X, R1 = R2 = 500\Omega$ | 2   | 30    | 2   | 25      | ns    |
| t <sub>dis</sub> | <b>OECB</b> ↑                       | СВ       | $S0 = H, S1 = X, R1 = R2 = 500\Omega$ | 2   | 30    | 2   | 25      | ns    |
| t <sub>en</sub>  | OEB0 thru OEB3↓                     | DB       | $S0 = H, S1 = X, R1 = R2 = 500\Omega$ | 2   | 30    | 2   | 25      | ns    |
| t <sub>dis</sub> | OEB0 thru OEB3 ↑                    | DB       | $S0 = H, S1 = X, R1 = R2 = 500\Omega$ | 2   | 30    | 2   | 25      | ns    |

# DP8403 Switching Characteristics $V_{CC} = 4.5V$ to 5.5V, $C_L = 50$ pF, $T_A = Min$ to Max (unless otherwise noted)

| <u> </u>         | From                                | То       | Test Conditions                               |     | Military |     | С   | ommerc | ial | Units |
|------------------|-------------------------------------|----------|-----------------------------------------------|-----|----------|-----|-----|--------|-----|-------|
| Symbol           | (Input)                             | (Output) |                                               | Min | Тур†     | Max | Min | Тур†   | Max | Units |
| t <sub>pd</sub>  | DB and CB                           | ERR      | $S1 = H, S0 = L, R_L = 500\Omega$             |     | 26       |     |     | 26     |     | ns    |
| чра              | DB                                  | ERR      | S1 = L, S0 = H, R <sub>L</sub> = 500 $\Omega$ |     | 26       |     |     | 26     |     | 113   |
|                  |                                     | MERR     | $S1 = H, S0 = L, R_L = 500\Omega$             |     | 40       |     |     | 40     |     |       |
| t <sub>pd</sub>  | DB and CB                           | MERR     | $S1 = L, S0 = H, R_L = 500\Omega$             |     | 40       |     |     | 40     |     | ns    |
| t <sub>pd</sub>  | S0 $\downarrow$ and S1 $\downarrow$ | СВ       | $R_L = 680\Omega$                             |     | 40       |     |     | 40     |     | ns    |
| t <sub>pd</sub>  | DB                                  | СВ       | $S1=L,S0=L,R_{L}=680\Omega$                   |     | 40       |     |     | 40     |     | ns    |
| t <sub>pd</sub>  | LEDB0↓                              | DB       | $S1 = X$ , $S0 = H$ , $R_L = 680\Omega$       |     | 26       |     |     | 26     |     | ns    |
| t <sub>pd</sub>  | S1 ↑                                | СВ       | $SO = H, R_L = 680\Omega$                     |     | 40       |     |     | 40     |     | ns    |
| t <sub>PLH</sub> | <b>OECB</b> ↑                       | СВ       | $S1 = X$ , $S0 = H$ , $R_L = 680\Omega$       |     | 24       |     |     | 24     |     | ns    |
| t <sub>PHL</sub> | <u>OECB</u> ↓                       | СВ       | $S1 = X, S0 = H, R_L = 680\Omega$             |     | 24       |     |     | 24     |     | ns    |
| t <sub>PLH</sub> | OEB0 thru OEB3 ↑                    | DB       | $S1 = X, S0 = H, R_L = 680\Omega$             |     | 24       |     |     | 24     |     | ns    |
| t <sub>PHL</sub> | OEB0 thru OEB3↓                     | DB       | $S1 = X$ , $S0 = H$ , $R_L = 680\Omega$       |     | 24       |     |     | 24     |     | ns    |

†All typical values are at  $V_{CC} = 5V$ ,  $T_A = +25^{\circ}C$ .



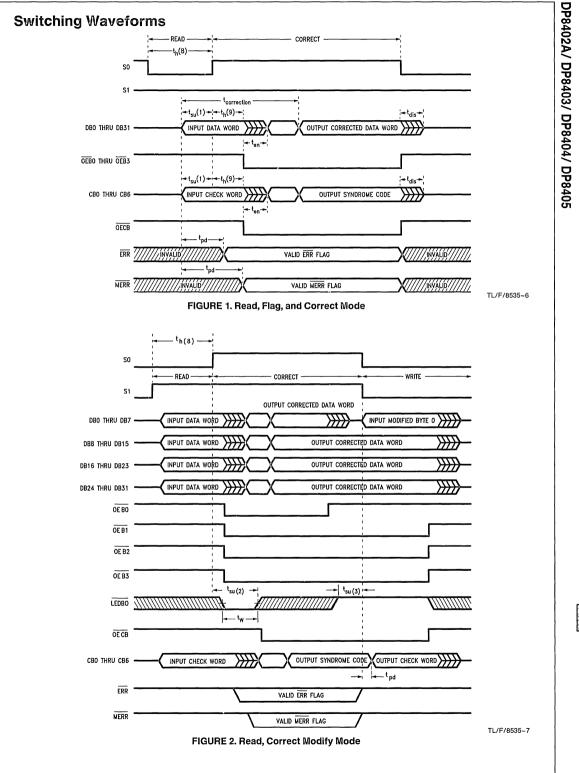
# DP8402A/ DP8403/ DP8404/ DP8405

| Symbol           | From                                | То       | Test Conditions                               |     | Military |     |     | Commercial |     |       |  |
|------------------|-------------------------------------|----------|-----------------------------------------------|-----|----------|-----|-----|------------|-----|-------|--|
| Cymbol           | (Input)                             | (Output) | rest conditions                               | Min | Тур†     | Max | Min | Typ†       | Max | Units |  |
| t <sub>pd</sub>  | DB and CB                           | ERR      | $S1 = H, S0 = L, R_L = 500\Omega$             |     | 26       |     |     | 26         |     | ns    |  |
| φa               | BB und OB                           | 2        | S1 = L, S0 = H, R <sub>L</sub> = 500 $\Omega$ |     | 26       |     |     | 26         |     | 110   |  |
| t <sub>pd</sub>  | DB and CB                           | MERR     | $S1 = H, S0 = L, R_L = 500\Omega$             |     | 40       |     |     | 40         |     | ns    |  |
| ъра              | BB and OB                           | WIEI UI  | $S1 = L, S0 = H, R_L = 500\Omega$             |     | 40       |     |     | 40         |     | 115   |  |
| t <sub>pd</sub>  | S0 $\downarrow$ and S1 $\downarrow$ | СВ       | $R1 = R2 = 500\Omega$                         |     | 35       |     |     | 35         |     | ns    |  |
| t <sub>pd</sub>  | DB                                  | СВ       | $S1 = L, S0 = L, R1 = R2 = 500\Omega$         |     | 35       |     |     | 35         |     | ns    |  |
| t <sub>pd</sub>  | S1 ↑                                | СВ       | $S0 = H, R1 = R2 = 500\Omega$                 |     | 35       |     |     | 35         |     | ns    |  |
| t <sub>en</sub>  | OECB↓                               | СВ       | $S1 = X, S0 = H, R1 = R2 = 500\Omega$         |     | 18       |     |     | 18         |     | ns    |  |
| t <sub>dis</sub> | OECB ↑                              | СВ       | $S1 = X, S0 = H, R1 = R2 = 500\Omega$         |     | 18       |     |     | 18         |     | ns    |  |
| t <sub>en</sub>  | <u>OECB</u> ↓                       | DB       | $S1 = X, S0 = H, R1 = R2 = 500\Omega$         |     | 18       |     |     | 18         |     | ns    |  |
| t <sub>dis</sub> | OECB↑                               | DB       | $S1 = X, S0 = H, R1 = R2 = 500\Omega$         |     | 18       |     |     | 18         |     | ns    |  |

#### **DP8405 Switching Characteristics,** $V_{CC} = 4.5V$ to 5.5V, $C_L = 50$ pF, $T_A = Min$ to Max

| 0                | From                                | То       | Test Conditions                                                                   |     | Military |     | С   | ommerc | ial | Units |
|------------------|-------------------------------------|----------|-----------------------------------------------------------------------------------|-----|----------|-----|-----|--------|-----|-------|
| Symbol           | (Input)                             | (Output) | Test conditions                                                                   | Min | Typ†     | Max | Min | Typ†   | Max | Unita |
| terel            | DB and CB                           | ERR      | $S1 = H, S0 = L, R_L = 500\Omega$                                                 |     | 26       |     |     | 26     |     | ns    |
| t <sub>pd</sub>  | DB                                  | ERR      | $\mathrm{S1}=\mathrm{L},\mathrm{S0}=\mathrm{H},\mathrm{R}_{\mathrm{L}}=500\Omega$ |     | 26       |     |     | 26     |     | 10    |
| t                | DB and CB                           | MERR     | $S1 = H, S0 = L, R_L = 500\Omega$                                                 |     | 40       |     |     | 40     |     | ns    |
| tpd              | DD and OD                           |          | $S1 = L, S0 = H, R_L = 500\Omega$                                                 |     | 40       |     |     | 40     |     | 115   |
| t <sub>pd</sub>  | S0 $\downarrow$ and S1 $\downarrow$ | СВ       | $R_L = 680\Omega$                                                                 |     | 40       |     |     | 40     |     | ns    |
| t <sub>pd</sub>  | DB                                  | СВ       | $S1 = L, S0 = L, R_L = 680\Omega$                                                 |     | 40       |     |     | 40     |     | ns    |
| t <sub>pd</sub>  | S1 ↑                                | DB       | $S0 = H, R_L = 680\Omega$                                                         |     | 40       |     |     | 40     |     | ns    |
| <sup>t</sup> PLH | <b>OECB</b> ↑                       | СВ       | $S1 = X, S0 = H, R_L = 500\Omega$                                                 |     | 24       |     |     | 24     |     | ns    |
| tPHL             | <u>OECB</u> ↓                       | СВ       | $S1 = X, S0 = H, R_L = 680\Omega$                                                 |     | 24       |     |     | 24     |     | ns    |
| t <sub>PLH</sub> | OEDB↑                               | DB       | $S1 = X, S0 = H, R_L = 680\Omega$                                                 |     | 24       |     |     | 24     |     | ns    |
| t <sub>PHL</sub> | <u>OEDB</u> ↓                       | DB       | $S1 = X, S0 = H, R_L = 680\Omega$                                                 |     | 24       |     |     | 24     |     | ns    |

†All typical values are at  $V_{CC} = 5V$ ,  $T_A = +25^{\circ}C$ .



#### Switching Waveforms (Continued)

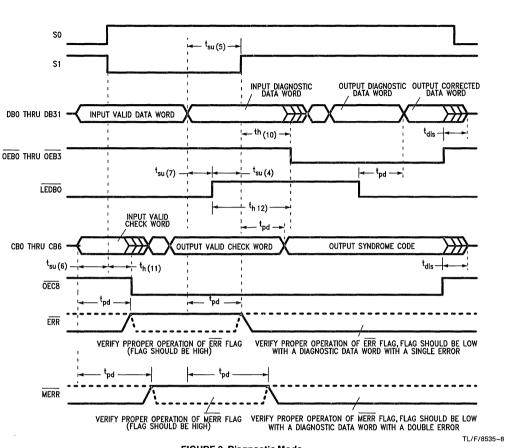
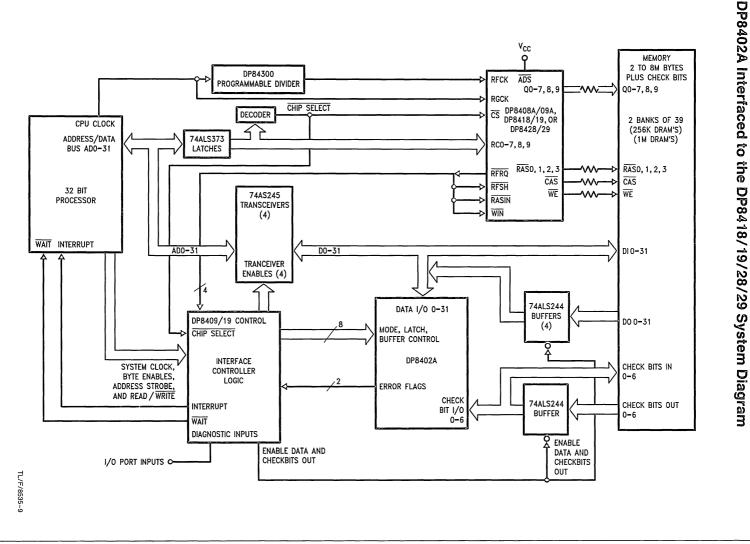


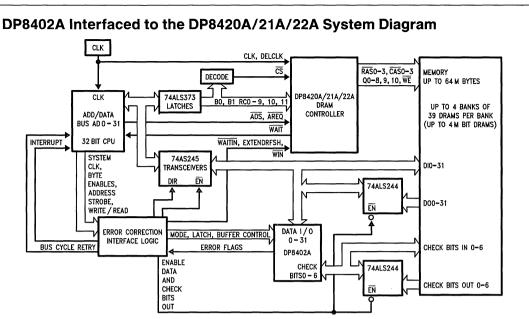
FIGURE 3. Diagnostic Mode

DP8402A/ DP8403/ DP8404/ DP8405



N

DP8402A/ DP8403/ DP8404/ DP8405



TI/F/8535-12

#### National Semiconductor

#### DP8406 (54F/74F632) 32-Bit Parallel Error Detection and Correction Circuit

#### **General Description**

The DP8406 device is a 32-bit parallel error detection and correction circuit (EDAC) in a 52-pin or 68-pin package. The EDAC uses a modified Hamming code to generate a 7-bit check word from a 32-bit data word. This check word is stored along with the data word during the memory write cycle. During the memory read cycle, the 39-bit words from memory are processed by the EDAC to determine if errors have occurred in memory.

Single-bit errors in the 32-bit data word are flagged and corrected.

Single-bit errors in the 7-bit check word are flagged, and the CPU sends the EDAC through the correction cycle even though the 32-bit data word is not in error. The correction cycle will simply pass along the original 32-bit data word in this case and produce error syndrome bits to pinpoint the error-generating location.

Dual-bit errors are flagged but not corrected. These errors may occur in any two bits of the 39-bit word from memory (two errors in the 32-bit data word, two errors in the 7-bit check word, or one error in each word). The gross-error condition of all LOWs or all HIGHs from memory will be detected. Otherwise, errors in three or more bits of the 39-bit word are beyond the capabilities of these devices to detect.

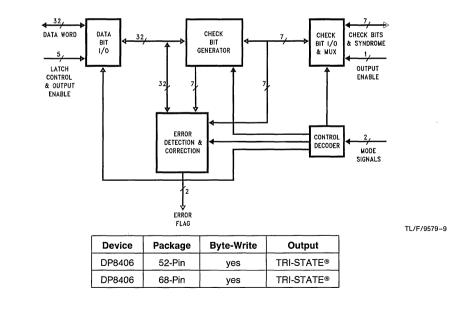
Read-modify-write (byte-control) operations can be performed by using output latch enable,  $\overline{\text{LEDBO}}$ , and the individual  $\overline{\text{OEB}}_0$  through  $\overline{\text{OEB}}_3$  byte control pins.

Diagnostics are performed on the EDACs by controls and internal paths that allow the user to read the contents of the Data Bit and Check Bit input latches. These will determine if the failure occurred in memory or in the EDAC.

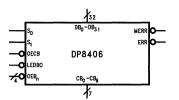
#### Features

- Detects and corrects single-bit errors
- Detects and flags dual-bit errors
- Built-in diagnostic capability
- Fast write and read cycle processing times
- Byte-write capability
- Guaranteed 4000V minimum ESD protection
- Fully pin and function compatible with TI's SN74ALS632A thru SN74ALS635 series

#### **Simplified Functional Block**



# Logic Symbol



TL/F/9579-1

# Unit Loading/Fan Out

|                                 |                              |                  | 54F/74F                                                                           |
|---------------------------------|------------------------------|------------------|-----------------------------------------------------------------------------------|
| Pin Names                       | Description                  | U.L.<br>HIGH/LOW | Input I <sub>IH</sub> /I <sub>IL</sub><br>Output I <sub>OH</sub> /I <sub>OL</sub> |
| CB0-CB6                         | Check Word Bit, Input        | 3.5/1.083        | 70 µA/—650 µA                                                                     |
|                                 | or TRI-STATE® Output         | 150/40 (33.3)    | -3 mA/24 mA (20 mA)                                                               |
| DB0-DB31                        | Data Word Bit, Input         | 3.5/1.083        | 70 μΑ/ 650 μΑ                                                                     |
|                                 | or TRI-STATE Output          | 150/40 (33.3)    | -3 mA/24 mA (20 mA)                                                               |
| OEB0-OEB3                       | Output Enable Data Bits      | 1.0/1.0          | 20 μA/ - 0.6 mA                                                                   |
| LEDBO                           | Output Latch Enable Data Bit | 1.0/1.0          | 20 μA/-0.6 mA                                                                     |
| OECB                            | Output Enable Check Bit      | 1.0/1.0          | 20 μA/ 0.6 mA                                                                     |
| S <sub>0</sub> , S <sub>1</sub> | Select Pins                  | 1.0/1.0          | $20 \mu \text{A} / -0.6 \text{mA}$                                                |
| ERR                             | Single Error Flag            | 50/33.3          | -1 mA/20 mA                                                                       |
| MERR                            | Multiple Error Flag          | 50/33.3          | —1 mA/20 mA                                                                       |

#### **Connection Diagrams** Pin Assignment **Pin Assignment** for LCC and PCC for LCC and PCC 68-Pin 52-Pin DB<sub>13</sub>DB<sub>12</sub>DB<sub>11</sub>DB<sub>10</sub> 000 1089 DB<sub>8</sub> CND DB<sub>7</sub> DB<sub>6</sub> 000 0005 DB<sub>4</sub> 20 19 18 17 16 15 14 13 12 11 10 9 8 DB14 DB12 DB12 DB12 DB11 DB110 DB110 DB110 DB110 DB12 DB12 DB12 DB13 NC 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 C 7 DB3 C 6 DB2 DB14 21 NC 27 NC 28 NC 29 NC 29 NC 29 NC 31 DB15 22 св6 23 🛋 (5 DB<sub>1</sub> 4 DB<sub>0</sub> CB5 24 DB15 30 E 3 ERR 2 MERR 4 1 LEDBO CB4 25 2 OECB 26 CB6 52 CB5 53 CB4 54 CB4 54 CB3 56 CB3 50 CB1 58 CB3 50 CB1 58 CB3 50 CB1 58 CB3 50 CB CB3 27 52 V<sub>CC</sub> CB2 28 CB129 51 S1 OECB 35 CB<sub>0</sub> 30 DB<sub>16</sub> 31 DB<sub>17</sub> 32 DB<sub>18</sub> 33 50 S<sub>0</sub> 49 DB31 48 DB30 47 DB29 DB16 40 DB17 41 34 35 36 37 38 39 40 41 42 43 44 45 46 DB19DB20DB210EB2DB22DB23CND DB24DB250EB3DB26DB27DB28 TL/F/9579-3 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 Order Number DP8406QV (74F632QC) See NS Package Number V52A DB18 DB21 DB21 DB21 DB22 OB22 GND DB24 CND DB24 OB25 OB26 NC NC

NC—No internal connection TL/F/9579-8 Order Number DP8406V (74F632VC) See NS Package Number V68A

 ③ NC

 ⑤ NC

 ⑤ NC

 ⑤ D02

 ⑤ D03

 ⑤ D04

 ⑥ D05

 ⑥ D05

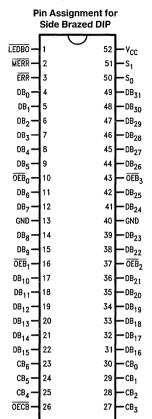
 ⑧ D05

 ⑧ D05

 ⑧ D05

 ◎ D05

### Connection Diagram (Continued)



# **Functional Description**

#### MEMORY WRITE CYCLE DETAILS

During a memory write cycle, the check bits (CB<sub>0</sub> through CB<sub>6</sub>) are generated internally in the EDAC by seven 16-input parity generators using the 32-bit data word as defined in Table II. These seven check bits are stored in memory along with the original 32-bit data word. This 32-bit word will later be used in the memory read cycle for error detection and correction.

#### ERROR DETECTION AND CORRECTION DETAILS

During a memory read cycle, the 7-bit check word is retrieved along with the actual data. In order to be able to determine whether the data from memory is acceptable to use as presented to the bus, the error flags must be tested to determine if they are at the HIGH level.

The first case in Table III represents the normal, no-error conditions. The EDAC presents HIGHs on both flags. The next two cases of single-bit errors give a HIGH on MERR and a LOW on ERR, which is the signal for a correctable error, and the EDAC should be sent through the correction cycle. The last three cases of double-bit errors will cause the EDAC to signal LOWs on both ERR and MERR, which is the interrupt indication for the CPU.

Error detection is accomplished as the 7-bit check word and the 32-bit data word from memory are applied to internal parity generators/checkers. If the parity of all seven groupings of data and check bits is correct, it is assumed that no error has occurred and both error flags will be HIGH.

Order Number DP8406D (74F632DC) See NS Package Number D52A

#### TABLE I. Write Control Function

TL/F/9579-2

| Memory<br>Cycle | EDAC<br>Function       | Cor<br>S <sub>1</sub> | ntrol<br>S <sub>0</sub> | Data I/O | DB Control<br>OEB <sub>n</sub> | DB Output<br>Latch<br>LEDBO | Check I/O            | CB<br>Control<br>OECB | Error<br>ERR | Flags<br>MERR |
|-----------------|------------------------|-----------------------|-------------------------|----------|--------------------------------|-----------------------------|----------------------|-----------------------|--------------|---------------|
| Write           | Generate<br>Check Word | L                     | L                       | Input    | н                              | х                           | Output<br>Check Bit* | L                     | н            | н             |

\*See Table II for details of check bit generation.

### Functional Description (Continued)

| Check Word      |        |        |        |        |        |      |        |       |        |       |        |      | 32     | -Bit   | Dat    | a W    | ord    |    |    |    |    |    |   |   |   |        |   |   |   |   |   |
|-----------------|--------|--------|--------|--------|--------|------|--------|-------|--------|-------|--------|------|--------|--------|--------|--------|--------|----|----|----|----|----|---|---|---|--------|---|---|---|---|---|
| Bit             | 31     | 30     | 29     | 28     | 27     | 26   | 25     | 24    | 23     | 22    | 21     | 20   | 19     | 18     | 17     | 16     | 15     | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6      | 5 | 4 | 3 | 2 | 1 |
| CB <sub>0</sub> | х      |        | Х      | X      |        | х    |        |       |        |       | Х      |      | Х      | х      | х      |        |        | х  |    |    | Х  |    | х | х | Х | х      |   | х |   |   |   |
| CB <sub>1</sub> |        |        |        | Х      |        | Х    |        | х     |        | х     |        | х    |        | Х      | х      | х      |        |    |    | х  |    | Х  |   | x |   | X      |   | x |   | х | x |
| CB <sub>2</sub> | х      |        | Х      |        |        | Х    | x      |       | х      |       |        | х    | Х      |        |        | х      | х      |    | х  |    |    | Х  | X |   | х |        |   | x | х |   |   |
| CB3             |        |        | Х      | Х      | х      |      |        |       | x      | х     | Х      |      |        |        | х      | х      |        |    | х  | х  | х  |    |   |   | х | X      | х |   |   |   | x |
| CB <sub>4</sub> | x      | Х      |        |        |        |      |        |       | x      | х     | х      | х    | Х      | х      |        |        | х      | Х  |    |    |    |    |   |   | Х | x      | х | x | х | x |   |
| CB <sub>5</sub> | х      | Х      | Х      | Х      | х      | Х    | X      | Х     |        |       |        |      |        |        |        |        | х      | Х  | Х  | х  | Х  | X  | x | x |   |        |   |   |   |   |   |
| CB <sub>6</sub> | x      | х      | Х      | х      | x      | х    | X      | х     |        |       |        |      |        |        |        |        |        |    |    |    |    |    |   |   | х | x      | х | х | х | х | x |
| The seven che   | eck bi | ts are | e pari | ty bit | s deri | ived | from t | the m | natrix | of da | ta bit | s as | indica | ated t | by X f | ior ea | ich bi | t. |    |    |    |    | • |   |   | •••••• |   |   |   |   |   |

| Total Numb       | er of Errors     | Erro | r Flags | Data Correction |
|------------------|------------------|------|---------|-----------------|
| 32-Bit Data Word | 7-Bit Check Word | ERR  | MERR    | Data correction |
| 0                | 0                | Н    | Н       | Not Applicable  |
| 1                | 0                | L    | н       | Correction      |
| 0                | 1                | L    | н       | Correction      |
| 1                | 1                | L    | L       | Interrupt       |
| 2                | 0                | L L  | L       | Interrupt       |
| 0                | 2                | L    | L       | Interrupt       |

H = HIGH Voltage Level L = LOW Voltage Level

If the parity of one or more of the check groups is incorrect, an error has occurred and the proper error flag or flags will be set LOW. Any single error in the 32-bit data word will change the state of either three or five bits of the 7-bit check word. Any single error in the 7-bit check word changes the state of only that one bit. In either case, the single error flag ( $\overline{ERR}$ ) will be set LOW while the dual error flag ( $\overline{MERR}$ ) will remain HIGH.

Any 2-bit error will change the state of an even number of check bits. The 2-bit error is not correctable since the parity tree can only identify single-bit errors. Both error flags are set LOW when any 2-bit error is detected.

Three or more simultaneous bit errors can cause the EDAC to believe that no error, a correctable error, or an uncorrectable error has occurred and will produce erroneous results in all three cases. It should be noted that the gross-error conditions of all LOWs and all HIGHs will be detected.

As the corrected word is made available on the data I/O port (DB<sub>0</sub> through DB<sub>31</sub>), the check word I/O port (CB<sub>0</sub> through CB<sub>6</sub>) presents a 7-bit syndrome error code. This syndrome error code can be used to locate the bad memory chip. See Table V for syndrome decoding.

#### **READ-MODIFY-WRITE (BYTE CONTROL) OPERATIONS**

The 'F632 device is capable of byte-write operations. The 39-bit word from memory must first be latched into the Data Bit and Check Bit input latches. This is easily accomplished by switching from the read and flag mode ( $S_1 = H, S_0 = L$ ) to the latch input mode ( $S_1 = H, S_0 = H$ ). The EDAC will then make any corrections, if necessary, to the data word and place it at the input of the output data latch. This data word must then be latched into the output data latch by taking <u>LEDBO</u> from a LOW to a HIGH.

Byte control can now be employed on the data word through the  $\overline{OEB}_0$  through  $\overline{OEB}_3$  controls.  $\overline{OEB}_0$  controls  $DB_0-DB_7$  (byte 0),  $\overline{OEB}_1$  controls  $DB_8-DB_{15}$  (byte 1),  $\overline{OEB}_2$  controls  $DB_{16}-DB_{23}$  (byte 2), and  $\overline{OEB}_3$  controls  $DB_{24}-DB_{31}$  (byte 3). Placing a HIGH on the byte control will disable the output and the user can modify the byte. If a LOW is placed on the byte control, then the original data word is altered through byte control, a new check word must be generated before it is written back into memory. This is easily accomplished by taking controls S\_1 and S\_0 LOW. Table VI lists the read-modify-write functions.

#### DIAGNOSTIC OPERATIONS

The 'F632 is capable of diagnostics that allow the user to determine whether the EDAC or the memory is failing. The diagnostic function tables will help the user to see the possibilities for diagnostic control. In the diagnostic mode  $(S_1 = L, S_0 = H)$ , the check word is latched into the input latch while the data input latch remains transparent. This lets the user apply various data words against a fixed known check word. If the user applies a diagnostic data word with an error in any bit location, the ERR flag should be LOW. If a diagnostic data word with two errors in any bit location is applied, the MERR flag should be LOW. After the check word is latched into the input latch, it can be verified by taking OECB LOW. This outputs the latched check word. The diagnostic data word can be latched into the output data latch and verified. By changing from the diagnostic mode ( $S_1 = L, S_0 = H$ ) to the correction mode ( $S_1 = H, S_0$ = H), the user can verify that the EDAC will correct the diagnostic data word. Also, the syndrome bits can be produced to verify that the EDAC pinpoints the error location. Table VII lists the diagnostic functions.

# Functional Description (Continued)

| TABLE IV. | Read, Fla | q and Cor  | rect Function |
|-----------|-----------|------------|---------------|
| 1710-2111 |           | ig ana oon | cot i anotion |

| Memory<br>Cycle | EDAC<br>Function                            | Cor<br>S <sub>1</sub> | itrol<br>S <sub>0</sub> | Data I/O                         | DB Control<br>OEB <sub>n</sub> | DB Output<br>Latch<br>LEDBO | Check I/O                           | CB<br>Control<br>OECB | Error Flags<br>ERR MERR |
|-----------------|---------------------------------------------|-----------------------|-------------------------|----------------------------------|--------------------------------|-----------------------------|-------------------------------------|-----------------------|-------------------------|
| Read            | Read & Flag                                 | Н                     | L                       | Input                            | н                              | X                           | Input                               | н                     | Enabled (Note 1)        |
| Read            | Latch Input<br>Data & Check<br>Bits         | Н                     | н                       | Latched<br>Input<br>Data         | Н                              | L                           | Latched<br>Input<br>Check Word      | н                     | Enabled (Note 1)        |
| Read            | Output<br>Corrected Data<br>& Syndrome Bits | н                     | н                       | Output<br>Corrected<br>Data Word | Ĺ                              | x                           | Output<br>Syndrome<br>Bits (Note 2) | L                     | Enabled (Note 1)        |

Note 1: See Table III for error description.

Note 2: See Table V for error location.

|                  |                  | Syne             | drome            | Bits             | 200              |                  | Error                                                  |
|------------------|------------------|------------------|------------------|------------------|------------------|------------------|--------------------------------------------------------|
| 6                | 5                | 4                | 3                | 2                | 1                | 0                | End                                                    |
| L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | unc<br>2-Bit<br>2-Bit<br>unc                           |
|                  | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>L      | H<br>H<br>H      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>unc<br>unc<br>2-Bit (Note 2)                  |
| L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>L      | H<br>H<br>H<br>H | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>unc<br>DB <sub>31</sub><br>2-Bit              |
|                  | L<br>L<br>L      | L<br>L<br>L      | нннн             | H H H H          |                  | LHLH             | unc<br>2-Bit<br>2-Bit<br>DB <sub>30</sub>              |
| L<br>L<br>L      | L<br>L<br>L      | H<br>H<br>H<br>H | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>unc<br>DB <sub>29</sub><br>2-Bit              |
| L<br>L<br>L<br>L | L<br>L<br>L<br>L | H<br>H<br>H<br>H | L<br>L<br>L      | H<br>H<br>H<br>H | L<br>L<br>H<br>H | L<br>H<br>L<br>H | DB <sub>28</sub><br>2-Bit<br>2-Bit<br>DB <sub>27</sub> |
| L<br>L<br>L      | L<br>L<br>L<br>L | H<br>H<br>H<br>H | H<br>H<br>H<br>H | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | DB <sub>26</sub><br>2-Bit<br>2-Bit<br>DB <sub>25</sub> |
| L<br>L<br>L      | L<br>L<br>L      | H<br>H<br>H<br>H | H<br>H<br>H<br>H | н<br>н<br>н<br>н | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>DB <sub>24</sub><br>unc<br>2-Bit              |

| ne Deco     | oaing            |                  |                  |                  |                  |                  |                                                      |
|-------------|------------------|------------------|------------------|------------------|------------------|------------------|------------------------------------------------------|
|             |                  | Syn              | drome            | Bits             |                  |                  | Error                                                |
| 6           | 5                | 4                | 3                | 2                | 1                | 0                | Liter                                                |
| L<br>L<br>L | H<br>H<br>H<br>H | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>H<br>H |                  | 2-Bit<br>unc<br>DB <sub>7</sub><br>2-Bit             |
|             | H<br>H<br>H<br>H | L<br>L<br>L      | L<br>L<br>L      | н<br>н<br>н<br>н | L<br>L<br>H<br>H | L<br>H<br>L<br>H | DB <sub>6</sub><br>2-Bit<br>2-Bit<br>DB <sub>5</sub> |
|             | H H H H          | L<br>L<br>L      | H H H H H        | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | DB <sub>4</sub><br>2-Bit<br>2-Bit<br>DB <sub>3</sub> |
|             | H<br>H<br>H<br>H | L<br>L<br>L      | нннн             | нннн             | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>DB <sub>2</sub><br>unc<br>2-Bit             |
| L<br>L<br>L | H<br>H<br>H<br>H | н<br>н<br>н<br>н | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>H<br>H |                  | DB <sub>0</sub><br>2-Bit<br>2-Bit<br>unc             |
| L<br>L<br>L | H<br>H<br>H      | H<br>H<br>H<br>H | L<br>L<br>L      | H<br>H<br>H<br>H | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>DB <sub>1</sub><br>unc<br>2-Bit             |
| L<br>L<br>L | H H H H          | HHHH             | ннн              | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>unc<br>unc<br>2-Bit                         |
| L<br>L<br>L | H<br>H<br>H<br>H | H<br>H<br>H<br>H | H<br>H<br>H<br>H | H<br>H<br>H<br>H | L<br>L<br>H<br>H | L<br>H<br>L<br>H | unc<br>2-bit<br>2-bit<br>CB <sub>6</sub>             |

 $CB_X = Error$  in check bit X

 $DB_Y = Error in data bit Y$ 

2-Bit = Double-bit error

unc = Uncorrectable multi-bit error

Note: 2-bit and unc condition will cause both ERR and MERR to be LOW Note 1: Syndrome bits for all LOWs. MERR and ERR LOW for all LOWs, only ERR LOW for  $DB_{30}$  error. Note 2: Syndrome bits for all HIGHs.



## Functional Description (Continued)

|                       |             | Syn                   | drome            | Bits             |                  |                  | Error                                                  |
|-----------------------|-------------|-----------------------|------------------|------------------|------------------|------------------|--------------------------------------------------------|
| 6                     | 5           | 4                     | 3                | 2                | 1                | 0                | LIIO                                                   |
| нннн                  | L<br>L<br>L | L<br>L<br>L           | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>H<br>H | LHLH             | 2-Bit<br>unc<br>unc<br>2-Bit                           |
| H<br>H<br>H           | L<br>L<br>L | L<br>L<br>L           | L<br>L<br>L      | H<br>H<br>H<br>H | L<br>L<br>H<br>H | L<br>H<br>L<br>H | unc<br>2-Bit<br>2-Bit<br>unc                           |
| HHHH                  | L<br>L<br>L | L<br>L<br>L           | нннн             | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | unc<br>2-Bit<br>2-Bit<br>DB <sub>15</sub>              |
| H<br>H<br>H<br>H      | L<br>L<br>L | L<br>L<br>L           | H<br>H<br>H<br>H | H<br>H<br>H<br>H | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>unc<br>DB <sub>14</sub><br>2-Bit              |
| H<br>H<br>H<br>H      | L<br>L<br>L | H<br>H<br>H<br>H<br>H | L<br>L<br>L      | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | unc<br>2-Bit<br>2-Bit<br>DB <sub>13</sub>              |
| H<br>H<br>H<br>H<br>H | L<br>L<br>L | H<br>H<br>H<br>H      | L<br>L<br>L      | H<br>H<br>H<br>H | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>DB <sub>12</sub><br>DB <sub>11</sub><br>2-Bit |
| ннн                   | L<br>L<br>L | HHHH                  | HHHH             | L<br>L<br>L      | L<br>L<br>H<br>H | L<br>H<br>L<br>H | 2-Bit<br>DB <sub>10</sub><br>DB <sub>9</sub><br>2-Bit  |
| H<br>H<br>H<br>H      | L<br>L<br>L | H<br>H<br>H<br>H      | нннн             | н<br>н<br>н<br>н | L<br>L<br>H<br>H | L<br>H<br>L<br>H | DB <sub>8</sub><br>2-Bit<br>2-Bit<br>CB <sub>5</sub>   |

#### TABLE V. Syndrome Decoding (Continued)

| oung | (Conti   | inucu) |          |      |   |   |                  |
|------|----------|--------|----------|------|---|---|------------------|
|      |          | Syne   | drome    | Bits |   |   | Error            |
| 6    | 5        | 4      | 3        | 2    | 1 | 0 |                  |
| Н    | н        | L      | L        | L    | L | L | unc              |
| н    | н        | L      | L        | L    | L | н | 2-Bit            |
| н    | н        | L      | L        | L    | н | L | 2-Bit            |
| Н    | Н        | L      | L        | L    | н | н | DB <sub>23</sub> |
| н    | Н        | L      | L        | Н    | L | L | 2-Bit            |
| н    | н        | L      | L        | н    | L | н | DB <sub>22</sub> |
| н    | н        | L      | L        | н    | н | L | DB <sub>21</sub> |
| н    | H        | L      | L        | Н    | Н | Н | 2-Bit            |
| н    | Н        | L      | Н        | L    | L | L | 2-Bit            |
| н    | н        | L      | н        | L    | L | H | DB <sub>20</sub> |
| Н    | н        | L      | н        | L    | н | L | DB <sub>19</sub> |
| н    | <u> </u> | L      | H        |      | Н | н | 2-Bit            |
| н    | н        | L      | н        | н    | L | L | DB <sub>18</sub> |
| н    | н        | L      | н        | н    | L | н | 2-Bit            |
| н    | н        | L      | н        | н    | н | L | 2-Bit            |
| н    | Η        | L      | Н        | H    | H | H | CB <sub>4</sub>  |
| н    | н        | Н      | L        | L    | L | L | 2-Bit            |
| Н    | Н        | Н      | L        | L    | L | Н | DB <sub>16</sub> |
| н    | Н        | н      | L        | L    | Н | L | unc              |
| Н    | Н        | н      | L        | L    | Н | Н | 2-Bit            |
| н    | н        | н      | L        | н    | L | L | DB <sub>17</sub> |
| н    | н        | н      | L        | н    | L | Н | 2-Bit            |
| н    | Н        | Н      | L        | Н    | Н | L | 2-Bit            |
| н    | H        | Н      | L        | H    | Н | Н | CB3              |
| н    | н        | н      | н        | L    | L | L | unc (Note 1)     |
| н    | Н        | Н      | Н        | L    | L | Н | 2-Bit            |
| н    | н        | Н      | н        | L    | Н | L | 2-Bit            |
| Н    | <u> </u> | Н      | <u> </u> | L    | H | H | CB <sub>2</sub>  |
| н    | н        | н      | Н        | н    | L | L | 2-Bit            |
| Н    | Н        | Н      | Н        | Н    | L | Н | CB1              |
| н    | н        | Н      | Н        | н    | Н | L | CB <sub>0</sub>  |
| н    | н        | н      | н        | н    | н | н | None             |

 $\begin{array}{l} CB_X = & \text{Error in check bit X} \\ DB_Y = & \text{Error in data bit Y} \\ \text{2-Bit} = & \text{Double-bit error} \end{array}$ 

unc = Uncorrectable multi-bit error

Note: 2-bit and unc condition will cause both ERR and MERR to be LOW Note 1: Syndrome bits for all LOWs. MERR and ERR LOW for all LOWs, only ERR LOW for DB<sub>30</sub> error. Note 2: Syndrome bits for all HIGHs.

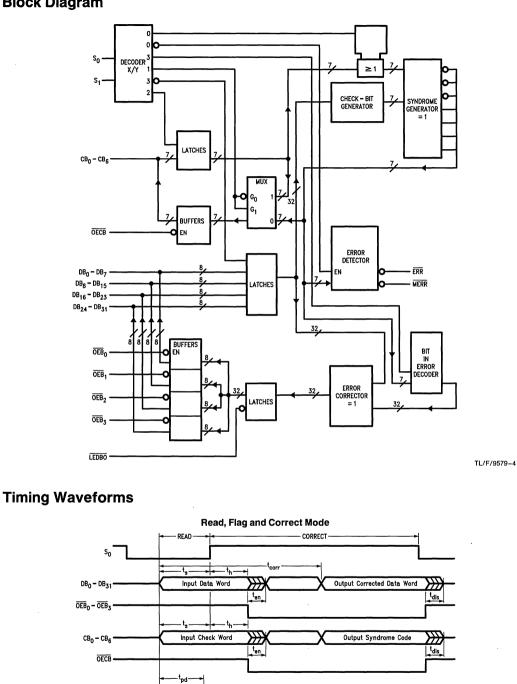
|                                                               |                                                        |                                    |                        | ТA                          | BLE VI                                | . Read-      | Modify-                      | Write Functi                          | on                                   |                                         |                                      |             |          |   |  |   |                                 |   |        |   |
|---------------------------------------------------------------|--------------------------------------------------------|------------------------------------|------------------------|-----------------------------|---------------------------------------|--------------|------------------------------|---------------------------------------|--------------------------------------|-----------------------------------------|--------------------------------------|-------------|----------|---|--|---|---------------------------------|---|--------|---|
| Memory<br>Cycle                                               | ED/<br>Func                                            |                                    | Co<br>S <sub>1</sub>   | ntrol<br>S <sub>0</sub>     | ВҮТ                                   | En*          | OEBn*                        | DB Outpu<br>Latch<br>LEDBO            | Check I/O                            | CB<br>Control<br>OECB                   | Error Fl<br>ERR Ñ                    | ags<br>IERR |          |   |  |   |                                 |   |        |   |
| Read                                                          | Read & F                                               | =lag                               | н                      | L                           | Input                                 |              | Н                            | x                                     | Input                                | н                                       | Enabled                              |             |          |   |  |   |                                 |   |        |   |
| Read                                                          | Latch Inp<br>Data &<br>Check Bi                        |                                    | ΥΗ                     | н                           | Latched<br>Input<br>Data              |              | н                            | L                                     | Latched<br>Input<br>Check Word       | н                                       | Enabled                              |             |          |   |  |   |                                 |   |        |   |
| Read                                                          | Latch Co<br>Data Wo<br>Output L                        | rd into                            | Н                      | Н                           | H Output<br>Data<br>Word              |              | Output<br>Data               |                                       | н                                    | н                                       | High Z<br>Output<br>Syndrome<br>Bits | H<br>L      | Enabled  |   |  |   |                                 |   |        |   |
| Modify/<br>Write                                              | Modify<br>Appropri<br>Byte or E<br>& Genera<br>Check W | Bytes<br>ate New                   | L                      | L                           | Input<br>Modifi<br>BYTE<br>Outpu      | o<br>it      | н                            | н                                     | Output<br>Check Word                 | i L                                     | н                                    | н           |          |   |  |   |                                 |   |        |   |
| *OEB <sub>0</sub> con                                         |                                                        |                                    | OEB <sub>1</sub> co    | ntrols DB <sub>8</sub> -    | Uncha<br>BYTE<br>DB <sub>15</sub> (BY | 0            | L<br>B <sub>2</sub> controls | DB <sub>16</sub> -DB <sub>23</sub> (B | $YTE_2$ ; $\overline{OEB}_3$ control | ls DB <sub>24</sub> –DB <sub>31</sub> ( | BYTE <sub>3</sub> ).                 |             |          |   |  |   |                                 |   |        |   |
|                                                               |                                                        |                                    |                        |                             | TABL                                  | E VII. D     | iagnosti                     | c Function                            |                                      |                                         |                                      |             |          |   |  |   |                                 |   |        |   |
| ED/<br>Func                                                   |                                                        | Con <sup>.</sup><br>S <sub>1</sub> | trol<br>S <sub>0</sub> | Data                        | 1/0                                   | DB B<br>Cont | rol                          | B Output<br>Latch<br>LEDBO            | Check I/O                            | CB<br>Control<br>OECB                   | Error Fla                            | igs<br>IERR |          |   |  |   |                                 |   |        |   |
| Read & Fl                                                     | ag                                                     | н                                  | L                      | Input C<br>Data W           |                                       | н            |                              | x                                     | Input Correct<br>Check Bits          | н                                       | н                                    |             |          |   |  |   |                                 |   |        |   |
| Latch Inpu<br>Word whil<br>Input Latc<br>Remains<br>Transpare | e Data<br>h                                            | L                                  | н                      | Input<br>Diagno<br>Data W   |                                       | н            |                              | L                                     | Latched<br>Input<br>Check Bits       | Н                                       | Enable                               | d           |          |   |  |   |                                 |   |        |   |
| Latch Diag<br>Data Word<br>Output La                          | d into                                                 | L                                  | Н                      | -                           | Diagnostic H                          |              | •                            |                                       | Diagnostic                           |                                         | Diagnostic                           |             | nostic H |   |  | н | Output<br>Latched<br>Check Bits | L | Enable | d |
| Latch Diag<br>Data Word<br>Input Latc                         | d into                                                 | stic Latched                       |                        | Input H                     |                                       | н            |                              | н                                     |                                      | н                                       | High Z<br>Output<br>Syndrome<br>Bits | L           | Enable   | d |  |   |                                 |   |        |   |
|                                                               |                                                        |                                    |                        | Data W                      |                                       |              |                              |                                       | High Z                               | н                                       |                                      |             |          |   |  |   |                                 |   |        |   |
| Output Dia<br>Data Word<br>Syndrome                           | &t                                                     | н                                  | Н                      | Output<br>Diagno<br>Data W  | stic                                  | L            |                              | н                                     | Output<br>Syndrome<br>Bits           | L                                       | Enabled                              |             |          |   |  |   |                                 |   |        |   |
|                                                               |                                                        |                                    |                        |                             |                                       |              |                              |                                       | High Z                               | Н                                       |                                      |             |          |   |  |   |                                 |   |        |   |
| Output Co<br>Diagnostic<br>Word & O                           | c Data<br>utput                                        | н                                  | н                      | Output<br>Correct<br>Diagno | ted<br>stic                           | L            |                              | L                                     | Output<br>Syndrome<br>Bits           | L                                       | Enable                               | d           |          |   |  |   |                                 |   |        |   |
| Syndrome                                                      | BITS                                                   |                                    |                        | Data W                      | ord                                   | 1            | í                            |                                       | High Z                               | н                                       |                                      |             |          |   |  |   |                                 |   |        |   |

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\*Diagnostic data is a data word with an error in one bit location except when testing the MERR error flag. In this case, the diagnostic data word will contain errors in two bit locations.



## **Block Diagram**



TL/F/9579-5

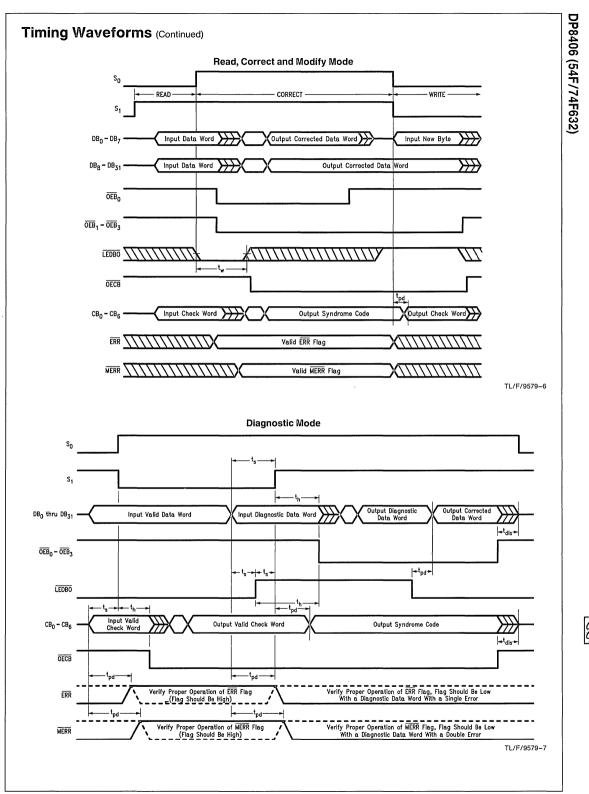
Valid ERR Flag

Valid MERR Flag

ERR \

MERR

t<sub>pd</sub>



### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| Storage Temperature                                              | -65°C to +150°C                            |
|------------------------------------------------------------------|--------------------------------------------|
| Ambient Temperature under Bias                                   | -55°C to +125°C                            |
| Junction Temperature under Bias                                  | -55°C to +175°C                            |
| V <sub>CC</sub> Pin Potential to<br>Ground Pin                   | -0.5V to +7.0V                             |
| Input Voltage (Note 2)                                           | -0.5V to +7.0V                             |
| Input Current (Note 2)                                           | -30 mA to +5.0 mA                          |
| Voltage Applied to Output<br>in HIGH State (with $V_{CC} = 0V$ ) |                                            |
| Standard Output<br>TRI-STATE Output                              | -0.5V to V <sub>CC</sub><br>-0.5V to +5.5V |
| •                                                                |                                            |

Current Applied to Output in LOW State (Max) twice th

ESD Last Passing Voltage (Min)

twice the rated I<sub>OL</sub> (mA) 4000V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# Recommended Operating Conditions

| Free Air Ambient Temperature |                 |
|------------------------------|-----------------|
| Military                     | -55°C to +125°C |
| Commercial                   | 0°C to +70°C    |
| Supply Voltage               |                 |
| Military                     | +4.5V to +5.5V  |
| Commercial                   | +4.5V to +5.5V  |
|                              |                 |

# **DC Electrical Characteristics**

| Symbol                             | Parame                                | tor                                                                                                                                                          |                                        | 54F/74 | F                 | Units | Vaa                                 | Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |  |  |
|------------------------------------|---------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------|--------|-------------------|-------|-------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Symbol                             | Farame                                | lei                                                                                                                                                          | Min                                    | Тур    | Max               | Units | Vcc                                 | Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |  |  |
| VIH                                | Input HIGH Voltage                    |                                                                                                                                                              | 2.0                                    |        |                   | V     |                                     | Recognized as a HIGH Signal                                                                                                                                                                                                                                                                                                                                                                                                                                                          |  |  |
| V <sub>IL</sub>                    | Input LOW Voltage                     |                                                                                                                                                              |                                        |        | 0.8               | V     |                                     | Recognized as a LOW Signal                                                                                                                                                                                                                                                                                                                                                                                                                                                           |  |  |
| V <sub>CD</sub>                    | Input Clamp Diode V                   |                                                                                                                                                              |                                        | -1.2   | V                 | Min   | $I_{IN} = -18 \text{ mA}$           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| V <sub>OH</sub>                    | Output HIGH<br>Voltage                | 54F 10% V <sub>CC</sub><br>54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 5% V <sub>CC</sub><br>74F 5% V <sub>CC</sub> | 2.5<br>2.4<br>2.5<br>2.4<br>2.7<br>2.7 |        |                   | v     | Min                                 | $ \begin{split} & I_{OH} = -1 \text{ mA} ( \overline{\text{ERR}}, \overline{\text{MERR}}, DB_n, CB_n ) \\ & I_{OH} = -3 \text{ mA} ( DB_n, CB_n ) \\ & I_{OH} = -1 \text{ mA} ( \overline{\text{ERR}}, \overline{\text{MERR}}, DB_n, CB_n ) \\ & I_{OH} = -3 \text{ mA} ( DB_n, CB_n ) \\ & I_{OH} = -1 \text{ mA} ( \overline{\text{ERR}}, \overline{\text{MERR}}, DB_n, CB_n ) \\ & I_{OH} = -3 \text{ mA} ( DB_n, CB_n ) \\ & I_{OH} = -3 \text{ mA} ( DB_n, CB_n ) \end{split} $ |  |  |
| V <sub>OL</sub>                    | Output LOW<br>Voltage                 | 54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub>                                                                                |                                        |        | 0.5<br>0.5<br>0.5 | v     | Min                                 | $\begin{split} I_{OL} &= 20 \text{ mA} \left( \overline{\text{ERR}}, \overline{\text{MERR}}, \text{DB}_n, \text{CB}_n \right) \\ I_{OL} &= 20 \text{ mA} \left( \overline{\text{ERR}}, \overline{\text{MERR}} \right) \\ I_{OL} &= 24 \text{ mA} \left( \text{DB}_n, \text{CB}_n \right) \end{split}$                                                                                                                                                                                |  |  |
| IH                                 | Input HIGH<br>Current                 | 54F<br>74F                                                                                                                                                   |                                        |        | 20.0<br>5.0       | μA    | Мах                                 | $V_{IN} = 2.7V (S_0, S_1, \overline{OEB}_n, \overline{OECB}, \overline{LEDBO})$                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| I <sub>BVI</sub>                   | Input HIGH Current<br>Breakdown Test  | 54F<br>74F                                                                                                                                                   |                                        |        | 100<br>7.0        | μΑ    | Max                                 | $V_{IN} = 7.0V (S_0, S_1, \overline{OEB}_n, \overline{OECB}, \overline{LEDBO})$                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| I <sub>BVIT</sub>                  | Input HIGH Current<br>Breakdown (I/O) | 54F<br>74F                                                                                                                                                   |                                        |        | 1.0<br>0.5        | mA    | Мах                                 | $V_{IN} = 5.5V (CB_n, DB_n)$                                                                                                                                                                                                                                                                                                                                                                                                                                                         |  |  |
| ICEX                               | Output HIGH<br>Leakage Current        | 54F<br>74F                                                                                                                                                   |                                        |        | 250<br>50         | μΑ    | Max                                 | V <sub>OUT</sub> = V <sub>CC</sub>                                                                                                                                                                                                                                                                                                                                                                                                                                                   |  |  |
| V <sub>ID</sub>                    | Input Leakage<br>Test                 | 74F                                                                                                                                                          | 4.75                                   |        |                   | v     | 0.0                                 | $I_{ID} = 1.9 \ \mu A$<br>All Other Pins Grounded                                                                                                                                                                                                                                                                                                                                                                                                                                    |  |  |
| I <sub>OD</sub>                    | Output Leakage<br>Circuit Current     | 74F                                                                                                                                                          |                                        |        | 3.75              | μΑ    | 0.0                                 | $V_{IOD} = 150 \text{ mV}$<br>All Other Pins Grounded                                                                                                                                                                                                                                                                                                                                                                                                                                |  |  |
| IIL                                | Input LOW Current                     |                                                                                                                                                              |                                        |        | -0.6              | mA    | Max                                 | $V_{IN} = 0.5V (S_0, S_1, \overline{OEB}_n, \overline{OECB}, \overline{LEDBO})$                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| I <sub>IH</sub> + I <sub>OZH</sub> | Output Leakage Cur                    | rent                                                                                                                                                         |                                        |        | 70                | μA    | Max                                 | $V_{I/O} = 2.7V (CB_n, DB_n)$                                                                                                                                                                                                                                                                                                                                                                                                                                                        |  |  |
| I <sub>IL</sub> + I <sub>OZL</sub> | Output Leakage Cur                    | rent                                                                                                                                                         |                                        |        | -650              | μA    | Max                                 | $V_{I/O} = 0.5V (CB_n, DB_n)$                                                                                                                                                                                                                                                                                                                                                                                                                                                        |  |  |
| I <sub>OZH</sub>                   | Output Leakage Cur                    |                                                                                                                                                              |                                        | 70     | μA                | Max   | $V_{I/O} = 2.7V (CB_n, DB_n)$       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| I <sub>OZL</sub>                   | Output Leakage Cur                    |                                                                                                                                                              |                                        | -650   | μA                | Max   | $V_{I/O} = 0.5V (CB_n, DB_n)$       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| l <sub>OS</sub>                    | Output Short-Circuit                  | Current                                                                                                                                                      | -60                                    |        | - 150             | mA    | Max                                 | V <sub>OUT</sub> = 0V                                                                                                                                                                                                                                                                                                                                                                                                                                                                |  |  |
| I <sub>ZZ</sub>                    | Bus Drainage Test                     |                                                                                                                                                              |                                        | 500    | μA                | 0.0V  | $V_{OUT} = 5.25V (CB_n, DB_n)$      |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| ICC                                | Power Supply Currer                   |                                                                                                                                                              |                                        | 340    | mA                | Max   | $T_{A} = 0^{\circ}C - 25^{\circ}C$  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |
| ICC                                | Power Supply Curre                    |                                                                                                                                                              |                                        | 325    | mA                | Max   | $T_{A} = 25^{\circ}C - 70^{\circ}C$ |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |  |  |

|                                      |                                                 |            | 74F                                                        |              | 54  | 4F               | 7                                                    | Units        |    |
|--------------------------------------|-------------------------------------------------|------------|------------------------------------------------------------|--------------|-----|------------------|------------------------------------------------------|--------------|----|
| Symbol                               | Parameter                                       | v          | $\Gamma_A = +25^{\circ}0$<br>$C_C = +5.0$<br>$C_L = 50$ pF | V            |     | c = Mil<br>50 pF | T <sub>A</sub> , V <sub>CC</sub><br>C <sub>L</sub> = |              |    |
|                                      |                                                 | Min        | Тур                                                        | Max          | Min | Max              | Min                                                  | Max          |    |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>DB or CB to ERR            | 4.0<br>4.0 | 14.0<br>10.5                                               | 27.0<br>18.0 |     |                  | 4.0<br>4.0                                           | 31.0<br>20.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>DB to ERR                  | 4.0<br>4.0 | 21.0<br>14.0                                               | 27.0<br>18.0 |     |                  | 4.0<br>4.0                                           | 31.0<br>20.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>DB or CB to MERR           | 5.0<br>5.0 | 17.0<br>16.0                                               | 27.0<br>27.0 |     |                  | 5.0<br>5.0                                           | 31.0<br>31.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>DB to MERR                 | 5.0<br>5.0 | 23.0<br>19.0                                               | 27.0<br>27.0 |     |                  | 5.0<br>5.0                                           | 31.0<br>31.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay $S_0$ and $S_1$ , LOW, to DB  | 4.0<br>4.0 | 12.0<br>12.0                                               | 16.0<br>16.0 |     |                  | 4.0<br>4.0                                           | 20.0<br>20.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>S <sub>1</sub> to CB       | 4.0<br>4.0 | 10.5<br>9.0                                                | 14.0<br>14.0 |     |                  | 4.0<br>4.0                                           | 15.0<br>15.0 | ns |
| tpLH                                 | Propagation Delay $S_0$ or $S_1$ to ERR or MERR | 2.0        | 11.5                                                       | 13.0         |     |                  | 2.0                                                  | 14.0         | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>DB to CB                   | 4.0<br>4.0 | 16.0<br>18.0                                               | 23.0<br>23.0 |     |                  | 4.0<br>4.0                                           | 25.0<br>25.0 | ns |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>LEDBO to DB                | 2.0<br>2.0 | 11.0<br>11.0                                               | 13.0<br>13.0 |     |                  | 2.0<br>2.0                                           | 14.0<br>14.0 | ns |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Output Enable Time<br>OEB <sub>n</sub> to DB    | 1.0<br>1.0 | 6.0<br>6.0                                                 | 10.0<br>10.0 |     |                  | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time<br>OEB <sub>n</sub> to DB   | 10<br>1.0  | 5.0<br>4.0                                                 | 10.0<br>10.0 |     |                  | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PZH</sub>                     | Output Enable Time<br>OECB to CB                | 1.0<br>1.0 | 6.0<br>6.0                                                 | 10.0<br>10.0 |     |                  | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time<br>OECB to CB               | 1.0<br>1.0 | 5.0<br>4.0                                                 | 10.0<br>10.0 |     |                  | 1.0<br>1.0                                           | 10.0<br>10.0 | ns |

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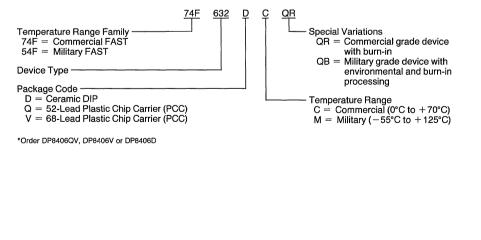
DP8406 (54F/74F632)

|                     |                                                                                                       | 7    | 4F               | 54                               | F       | 74                               |       |    |
|---------------------|-------------------------------------------------------------------------------------------------------|------|------------------|----------------------------------|---------|----------------------------------|-------|----|
| Symbol              | Parameter                                                                                             |      | + 25°C<br>+ 5.0V | T <sub>A</sub> , V <sub>CC</sub> | ; = Mil | T <sub>A</sub> , V <sub>CC</sub> | Units |    |
|                     |                                                                                                       | Min  | Max              | Min                              | Max     | Min                              | Max   |    |
| t <sub>s</sub>      | Setup Time, HIGH or LOW<br>DB/CB before S <sub>0</sub> HIGH (S <sub>1</sub> HIGH)                     | 3.0  |                  |                                  |         | 3.0                              |       | ns |
| t <sub>s</sub> (H)  | Setup Time, HIGH S <sub>0</sub> HIGH before $\overline{\text{LEDBO}}$ HIGH                            | 12.0 |                  |                                  |         | 14.0                             |       | ns |
| t <sub>s</sub> (H)  | Setup Time, HIGH LEDBO HIGH before $S_0$ or $S_1$ LOW                                                 | 0    |                  |                                  |         | 0                                |       | ns |
| t <sub>s</sub> (H)  | Setup Time, HIGH<br>LEDBO HIGH before S <sub>1</sub> HIGH                                             | 0    |                  |                                  |         | 0                                |       | ns |
| ts                  | Setup Time, HIGH or LOW<br>Diagnostic DB before S <sub>1</sub> HIGH                                   | 0    |                  |                                  |         | 0                                |       | ns |
| ts                  | Setup Time, HIGH or LOW<br>Diagnostic CB before<br>S1 LOW or S0 HIGH                                  | 3.0  |                  |                                  |         | 3.0                              |       | ns |
| t <sub>s</sub>      | Setup Time, HIGH or LOW<br>Diagnostic DB before<br>LEDBO HIGH (S1 LOW, S0 HIGH)                       | 8.0  |                  |                                  |         | 8.0                              |       | ns |
| t <sub>h</sub> (L)  | Hold Time, LOW<br>S <sub>0</sub> LOW after S <sub>1</sub> HIGH                                        | 8.0  |                  |                                  |         | 8.0                              |       | ns |
| t <sub>h</sub>      | Hold Time, HIGH or LOW<br>DB and CB Hold after S <sub>0</sub> HIGH                                    | 8.0  |                  |                                  |         | 8.0                              |       | ns |
| t <sub>h</sub>      | Hold Time, HIGH or LOW<br>DB Hold after S <sub>1</sub> HIGH                                           | 8.0  |                  |                                  |         | 8.0                              |       | ns |
| t <sub>h</sub>      | Hold Time, HIGH or LOW CB Hold after $S_1$ LOW or $S_0$ HIGH                                          | 5.0  |                  |                                  |         | 5.0                              |       | ns |
| t <sub>h</sub>      | Hold Time, HIGH or LOW<br>Diagnostic DB after<br>LEDBO HIGH (S <sub>1</sub> LOW, S <sub>0</sub> HIGH) | 0    |                  |                                  |         | 0                                |       | ns |
| t <sub>w</sub> (L)* | LEDBO Pulse Width                                                                                     | 8.0  |                  |                                  |         | 8.0                              |       | ns |
| t <sub>corr</sub> * | Correction Time                                                                                       |      | 25.0             |                                  |         |                                  | 28.0  | ns |

\*Note: These parameters are guaranteed by characterization or other tests performed.

# **Ordering Information**

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



# Expanding the Versatility of the DP8400

#### **BASIC OPERATION OF THE DP8400**

Introducing error correction capabilities to a memory incurs some penalties-extra memory, additional access times, and extra control circuitry. The DP8400 has been designed to minimize the last two, and for some data word widths, less extra memory is required than for other error correction circuits.

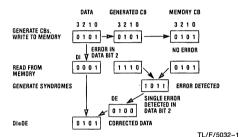
In systems using error correction, extra memory is needed for check bits, which are merely parity bits, each derived from different combinations of the data bits. If a single error does occur, the error correction circuit can determine which bit is in error and then complement that bit, to re-create the original data word. As the memory data word widens, the ratio of check bits to memory data bits is reduced. As a rough guide, starting with four data bits and four check bits, one additional check bit is required each time the data word doubles.

A circuit diagram of how the DP8400 generates the check bits in a write cycle and corrects errors in a read cycle is shown in *Figure 1a*, which uses four data bits and four check bits. A 4-bit example is shown in *Figure 1b*. In a write cycle, the data input latch, DIL, receives the system data and generates four parity bits or check bits, which pass through the check bit output latch, COL, and buffer, to be written to the selected memory location with the system data. This delays every write cycle, but fortunately the DP8400 takes only 30 ns extra to generate the (six) check bits. When this location is subsequently read, the four memory data bits pass through DIL to generate four new check National Semiconductor Application Note 306 Mike Evans

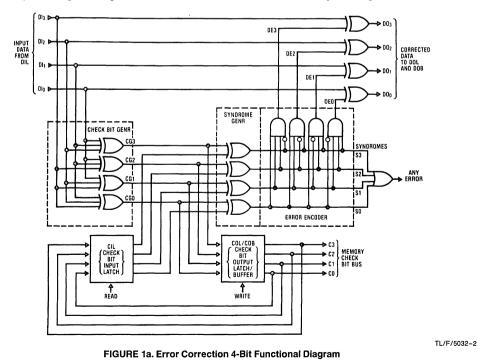


AN-306

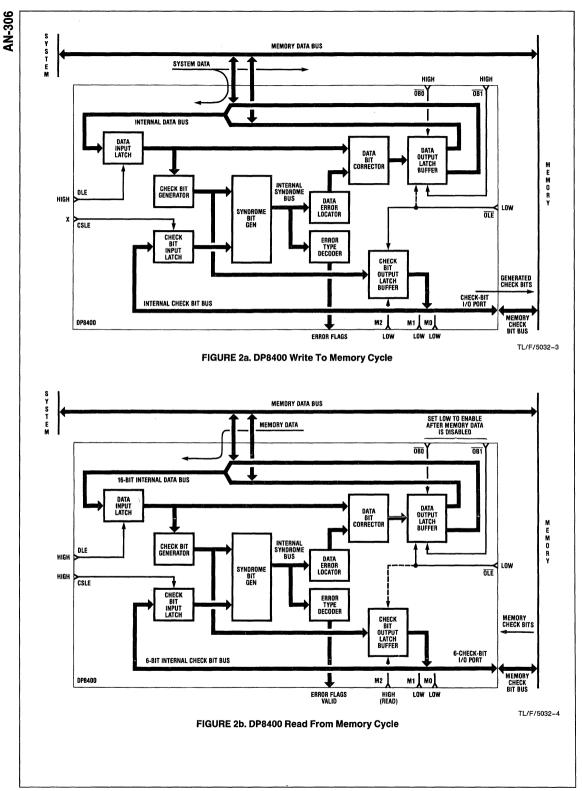
bits. The four memory check bits pass through the check bit input latch, CIL, and are fed into four Exclusive-OR gates with the four generated check bits. The outputs of these gates are called syndrome bits, and obviously, if there are no errors, the two sets of check bits will be the same and no syndrome bits will go high. If there is an error in the check bits, only the corresponding syndrome bit will go high; in this case the data bits are still correct. If one of the data bits is in error, three syndrome bits will go high (in the case of DP8400, three or five will go high), and the syndrome word is unique for any of the bits in error. The four AND-gates decode which bit is in error and complement it out of the second set of Exclusive-OR gates. The other three output bits remain the same as the input bits, so the corrected word is now available to the system.







2



In the case of the DP8400 with 16 data bits and 6 check bits, there are 16 AND-gates to decode the 6 syndrome bits to determine the data bit in error. Table I shows the DP8400 matrix, called a Nelson Code, which has some unique features concerned with double soft error correction. For the purposes of this description, the matrix may be considered to be a form of Modified Hamming Code. The matrix has two functions: horizontally it tells us the value of the generated check bits for any data word when writing to memory, and vertically it tells us the syndrome word for any data bit in error. In a write cycle to memory, a '1' in any row indicates that the data bit in that column helps generate the parity bit in that row. For example, check bit 1 checks the parity of data bits 3, 6, 8, 9, 11, 13, 14 and 15, and generates even parity for those data bits. In a read cycle from memory, three or five of the six syndrome bits will go high for a single data bit error, and the columns represent the syndrome word, so the data bit in error is the number at the top of the column for that syndrome word. The 16 AND-gates each decode one of the 16 syndrome words shown in the columns of Table I, to locate the error. If there is a data bit error, one of the outputs of the 16 AND-gates will go high, to complement the data bit in error.

If two errors have occurred, the syndrome word is simply the Exclusive-OR of the syndrome words of the two individual bits in error, whether data or check bits, and is always even parity. First, if two check bits are in error, the corresponding two syndrome bits will go high. Second, for one data bit and one check bit error, then either two, four or six syndrome bits will go high. Finally, if two data bits are in error, again two, four or six syndrome bits go high. Thus a parity on the syndromes will indicate any two errors. This is important because if we know there are two errors, the DP8400 can attempt to correct them. The third error flag, E1, is the parity of the syndrome bus and check bit error. The DP8400 provides three error flags AE (Any error), E0 and E1, as shown in Table II, so that the exact nature of the error can be determined.

#### **CONFIGURATION AND CONTROL OF THE DP8400**

The DP8400 has a 16-bit data I/O port and an 8-bit check bit I/O port (6 bits used with 16 data bits) for applications with memories used with 16-bit microprocessors. The 16-bit data I/O port sits on the memory data bus, and the 6 check bit I/O port connects directly to the check bit section of memory. In other words, each memory location now contains 16 data bits with 6 check bits. The DP8400 is expandable to beyond 80 data bits, each additional 16 data bits requiring an additional DP8400 without the need for extra logic circuitry. 32-bit wide memory busses are also a popular width for minicomputers. In addition, 16-bit microprocessor systems may use 32-bit memory, because this larger memory data width requires only 7 check bits, a lower percentage overhead of check bits to data bits.

Figures 2a and 2b show a simplified block diagram of the DP8400 with its control signals. The numerous control signals provide ease of use in the many varied applications of this chip. There are three latch enable signals DLE, CSLE and OLE. Whenever DLE is high, data on the data I/O port D0–15 is entered into the data input latch DIL, and is latched in as DLE goes low. This allows either processor or memory data to be present on the data bus for only 3 ns prior to, and held over for 10 ns after DLE goes low. The data can then be removed if desired. Similarly, CSLE, when high, allows check bits on the check bit I/O port and external data on the syndrome I/O port to enter the check bit and

syndrome input latches (CIL and SIL), respectively. These are latched in as CSLE goes low. (In 16-bit operation, OES, Output Enable Syndromes, will be set low permanently, inhibiting CSLE to SIL, which remains in the power-up reset condition so that it does not affect the simplified block diagram.) OLE, when set low, allows internal information into the data and check bit output latches (and the syndrome output latch, not shown). As OLE goes high, this information becomes latched. For some less complex designs, DLE, CSLE and OLE may be linked together. Providing OLE was low to allow corrected data into DOL, then OBO and OB1, when set low, enable the two data output buffers to present corrected data to the system. Data is enabled or disabled within 15 ns of these inputs going low or high, respectively. The DP8400 has three mode pins, M2, M1 and M0, which offer eight major modes of operation, designated 0 to 7. The most important two are Normal Write and Normal Read, and for these M1 and M0 are set low. M2 is READ/WRITE so Normal Write is mode 0 and Normal Read is mode 4. Other modes are used for the Double Complement Correct approach (Modes 1, 3 and 5) and for diagnostics (Modes 2 and 6). Mode 7 used when expanded to more than 16 data bits and fast correction times are required.

#### NORMAL OPERATION WITH A 16 DATA BIT MEMORY

The basic requirements for normal operation of the DP8400 are that it generates check bits, detect errors and correct them with minimum delays, and that it be easy to use. In normal operation M1 and M0 are set low. Figure 2a shows how the DP8400 generates check bits when writing data to memory. DLE may be kept high, OLE low, CSLE low, and M2 low so that the DP8400 is in Mode 0. System data is presented to the data I/O port on pins D0-15, and enters DIL, where it connects to the check bit generator CG. The six generated check bits pass through COL and are enabled (with M2 low) onto the check bit I/O port. The six generated check bits will appear 30 ns after the 16 data bits are presented to the data I/O port. A write to memory will now store the 16 data bits and 6 corresponding check bits in the selected location of memory. The write cycle is therefore slowed down by 30 ns, which in most memory systems is not significant.

Figure 2b shows the paths when reading from memory, with DLE set high to enter the memory data bits into DIL, and CSLE also set high to enter memory check bits into CIL. M2 is set high so that the DP8400 is in Mode 4. The Any Error flag, AE, becomes valid 35 ns after memory data and check bits are valid. Error flags E1 and E0 become valid approximately 15 ns later. Thus, if AE is low, no further operations are necessary. For fast 16-bit microprocessor systems, it may be necessary to introduce a wait state every read cycle to first determine if an error exists. If no error is detected the wait state is removed and the read cycle continues.

If an error is detected, then the error flags E1 and E0 must be examined to determine the required action. If the error is a single data bit error, DOL will by now contain corrected data. If there is no check bit error, then COL, which follows CIL when in Mode 4, now contains the original check bits. By taking  $\overline{\text{OLE}}$  high, corrected data bits are latched in DOL, and correct check bits in COL. The memory is now disabled, so that  $\overline{\text{OBO}}$  and  $\overline{\text{OB1}}$  can be set low to enable corrected data onto the data bus, and M2 set low to enable the contents of COL onto the check bit bus. A write to the same location of memory will therefore remove the data bit error if it was a soft error. The microprocessor can read the corrected data once the wait signal is removed.

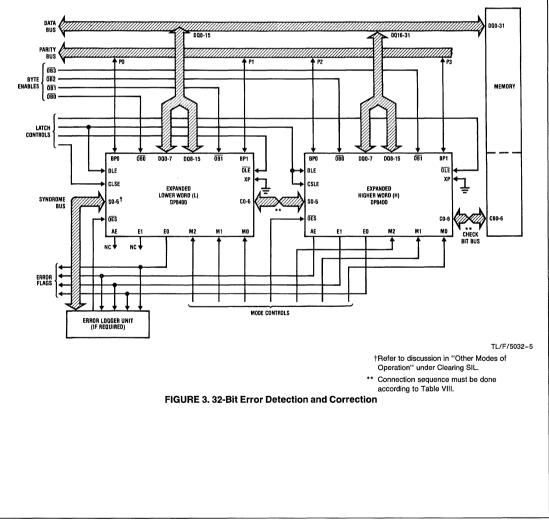
If the error is a single check bit error, DLE should be set low. DOL contains the contents of DIL, still correct data. Memory can now be disabled so that  $\overline{OB0}$  and  $\overline{OB1}$ , when set low, output correct data, and M2 when set low, allows the generated check bits from DIL to be output on the check bit I/O port. A write to the same location of memory will remove the check bit error if it was a soft error. The microprocessor now reads this correct data when the wait signal is removed. If a double bit error is detected, then other approaches may be taken, as described in the data sheet and later in this application note.

The primary features of the DP8400 are discussed in the data sheet; there are, however, a number of other features that become very useful once a designer becomes acquainted with error correcting techniques.

These include: expansion beyond 16 data bits, diagnostic routines, error logging (allowing some double error correction), and a novel approach offering fast correction of any double error. This application note discusses how the DP8400 has been designed to function in all of these applications, making it the most versatile and comprehensive error correction chip available.

#### ERROR CHECKING AND CORRECTING FOR WIDER-THAN-16-BITS DATA WIDTHS

At present, most 16-bit microprocessor systems use a 16-bit wide main memory, partly for simplicity, and also because main memories, in general, have not become large enough in size to justify otherwise. The data sheet shows how to accomplish this with one DP8400, utilizing the matrix of Table I. It is fairly easy to use a memory of twice the microprocessor data width to reduce total chip count when incorporating error correction capability. One example would be a complex 8-bit microprocessor using large main memory. If the memory data width is kept at eight bits, then five check bits are required for error correction for each byte of data. If four banks of memory are required, each bank comprising 13 chips, then 52 total memory chips are required and only 62% of the memory is used for system data. If the memory data width is increased to 16 bits for the same microprocessor-based system, then six check bits are required.



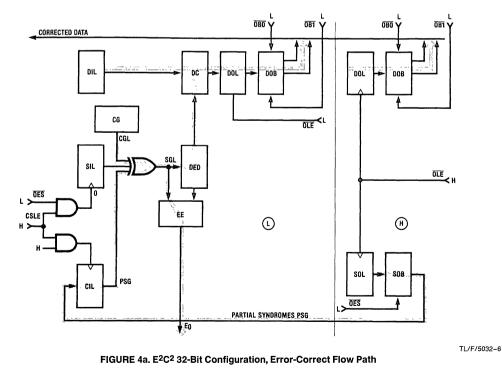
The memory now comprises two banks each of 22 chips, totaling 44 memory chips–a savings of eight memory chips. This saving is offset somewhat by the need to incorporate byte-writing capability, which does require extra components and slows down the memory write cycle. One DP8400 is still needed, using all 16 bits, and two bidirectional buffers are also required.

As a second example, using a 16-bit microprocessor with a memory of eight banks, each comprising 16 bits of data and six check bits, the total is  $8 \times 22$  or 176 memory chips. Once the memory is widened to 32 data bits with seven check bits, only four banks are required, and the total number of memory chips reduces to  $4 \times 39$ , or 156—a savings of 20 memory chips. This is offset a little by the fact that an extra DP8400 is required, and slightly slower memory write and read cycles are necessary. In some cases, therefore, widening the memory data bus becomes more practical for large memories.

Saving memory chips is just one reason why there is a need to be able to expand the DP8400 beyond 16 data bits. Most minicomputers now use 32-bit wide data busses, and soon there will be some 32-bit microprocessors. Other systems use 24 bits, 48 bits, 52 bits, 64 bits or a variety of other data widths. The DP8400 has been configured to be expandable to any data width, even beyond 80 bits, merely by inserting an additional DP8400 for each 16-bit increment in memory data.

A section of the chip shown in the data sheet Block Diagram comprises the syndrome input and output latches, SIL and-SOL, and a dedicated syndrome I/O port. This port has a number of uses not normally needed in simple 16-bit single error correction applications.

One use of this syndrome port is for data widths wider than 16 bits. Only one DP8400 is required with 16 data bits or less, but if a system uses more than 16 memory data bits, additional DP8400s are required. For example, two DP8400s, one with its 16-bit data port connected to the lower word, and the other to the higher word, can be configured to generate check bits, and detect and correct errors for a 32-bit memory as shown in Figure 3. For writing to memory, both chips will still generate six check bits from the two words of 16 bits. But with more than 26 total data bits, seven check bits are required. Therefore, it is necessary to combine the two sets of check bits to produce seven composite check bits to be written to memory as shown in the flow path depicted in Figure 4a. This is achieved by outputting the six generated check bits from the lower word DP8400 (designated L), and inputting them to H, the higher word DP8400. The syndrome port of H is available to receive these check bits from L, to be loaded into SIL of H, provided CSLE is high. The six outputs from SIL combine with the six check bits generated in H to create seven composite check bits, and this 7-bit combination is output on the check bit port to the memory check bits. Table II shows one of twelve possible ways to combine the two sets of check bits. Note that the lower word matrix for bits 0 and 15 is identical to Table I with the addition of all "0"s for the seventh check bit. The higher word matrix for bits 16 to 31 uses the same rows but in a different order, implying that the check bits from L must be cross-connected to H. For example, memory check bit 5 is generated from check bit 1 of L and check bit 5 of H. Both chips are therefore set to normal write mode when generating check bits.

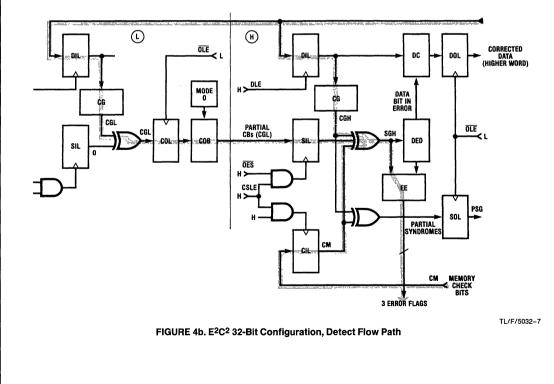


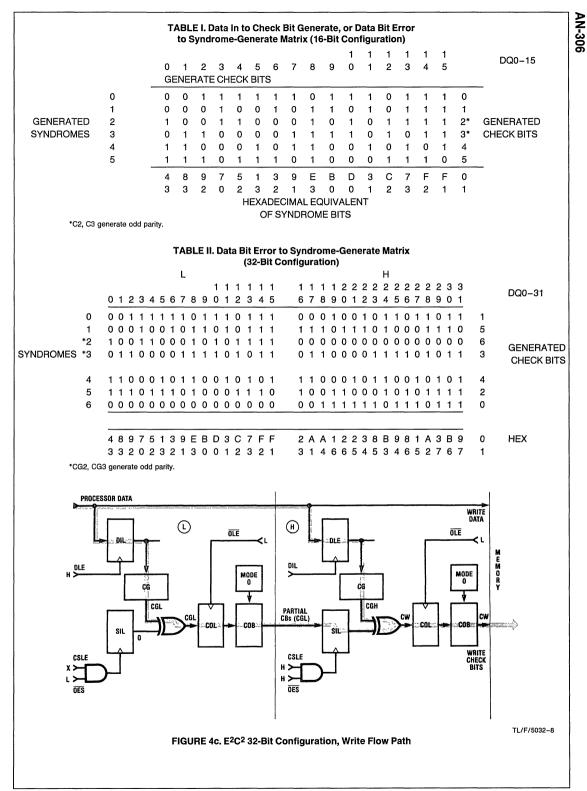
When reading from memory, the two chips first need to detect for an error. Figure 4b shows the flow path through the chips. L is set to normal write mode and H to normal read mode. Memory data is supplied to both chips so that L generates six check bits from the lower word data bits, and feeds them to SIL of H, the same as for writing. H also generates its own check bits which combine with those from L, and these seven composite check bits are compared with the seven memory check bits fed into CIL of H. This combining, plus comparison of check bits, is equivalent to seven 3input Exclusive-OR gates. The output of these Exclusive-OR gates are the seven syndrome bits, and these can be decoded to determine the type of error. First, if there is no error, error flag AE of H will remain inactive because memory data is correct, provided OLE is kept low, and DOL of both L and H will contain correct data. Second, if there is a memory check bit error, only one of the seven syndromes will go high and the three error flags of H will indicate a check bit error as in Table III. Note that memory data is still correct, and with OLE low, DOL of both L and H contain correct data. Third, if there is a single data error in bits 16-31, the syndromes of H are such that the data error locator will locate the error and correct it, so again DOL of both L and H contain correct data. This is because the seventh syndrome bit is low for an error in the higher word, so that we have a six syndrome bit word as in Table I, to be decoded as normal to correct the error. In each of these three cases, DOL of both L and H contained correct data, and the common condition for these is either that AE(H) is "0", or E1(H) is "1".

The fourth case is more complex. In the previous three cases, correct data has been available in both DOL about 50 ns after memory data became valid. Now with a single

data error in bits 0-15. AE(H) is a "1". E1(H) a "1". and EO(H) a "0", but L does not have sufficient information to locate the error. It is first necessary to feed back the partially generated syndromes of H back to L, and this is achieved by reversing the direction of the common bus. First L is placed in normal read mode so that L's generated check bits become disabled. Next, the partial syndromes in H are enabled onto the bus by setting OES of H low, so that its syndrome I/O port outputs the combined Exclusive-OR of CG(H) and CIL(H), which is transferred to CIL of L. These partial syndromes then combine with CG(L) to generate valid syndrome bits in L, demonstrated by the flow path of Figure 4c. If there is, in fact, a data bit error in bits 0-15, the seventh syndrome bit will go low, allowing the remaining six bits to be decoded to locate the error as per the columns of Table II. This switching around of the common bus, therefore, takes more time to correct the error in L, equivalent to a total time of approximately 100 ns. The fifth kind of error is identified as a double error. In this case, the error flags indicate the double error and the system can take the necessarv action.

A logical approach when using two DP8400s would be to first see if there is any need to reverse the common bus by monitoring AE(H), and when it is low, to output directly from DOL of both chips by setting  $\overline{OB0}$  and  $\overline{OB1}$  of each low. The System Data Valid flag should be set active at this time. If the AE(H) output is high and the error flags do not indicate a double error, then the common bus should be switched around and the System Data Valid signal set true. If the error is a double error, the user may utilize a number of alternatives, including the Double Complement Correct method.





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2

#### TABLE III. Error Flags After Normal Read (32-Bit Configuration)

| AE (H) | E1 (H) | E0(H) | E0(L)* | Error Type                |
|--------|--------|-------|--------|---------------------------|
| 0      | 0      | 0     | 0      | No Error                  |
| 1      | 1      | 0     | 0      | Single check bit error    |
| 1      | 1      | 1     | 0      | Single data bit error (H) |
| 1      | 1      | 0     | 1      | Single data bit error (L) |
| 1      | 0      | 0     | 0      | Double bit error          |
|        | All O  | thers |        | Invalid conditions        |

\*E0 (L) is valid after transfer of partial syndromes from higher to lower.

This approach to wider data width error detection and correction is termed the cascade configuration, and it requires only the one additional DP8400. The cascade approach can be used with up to five DP8400s controlling 80 data bits. The advantage is that only one additional DP8400 is required per 16 data bits, although write and read times become progressively slower as the number of DP8400s is increased. This is because of the time taken for the generated check bits to ripple through from the lowest to highest chips when writing and detecting, and then ripple back the other way for correcting.

In many memory systems, speed is of utmost importance and for faster systems, it is possible to connect the DP8400s in a parallel configuration using additional ICs. Application Note AN-308 describes this approach in detail.

The user may, therefore, select one of these approaches (or a combination of both) for systems using memory data widths of more than 16 bits.

#### DIAGNOSTIC CAPABILITIES OF THE DP8400

The DP8400 has been designed with system fault diagnois in mind. In fact, it is possible under microprocessor control with the DP8400 in site on the memory board to fully test every gate inside the DP8400 activated in normal operation, and also to diagnose all memory check bits. The DP8400 has two main diagnostic modes-modes 2 and 6. In other words, with M1 set high and M0 set low, information can be written to or read from the chip.

Mode 6 allows the memory check bits to be read onto the higher byte bits 8–14, and syndromes to be read on the lower byte bits 0–6, as shown in *Figure 5a*. The remaining two bits, 7 and 15, are the error flags E1 and E0 that were valid when mode 6 was entered. The syndrome bits will be the internally generated syndromes if  $\overline{\text{DES}}$  is low (mode 6A), or external syndromes input on the syndrome 1/O port if  $\overline{\text{OES}}$  is high (mode 6B). The external syndromes could be obtained from an error logger/syndrome injector unit—this is an error logger with the capability of injecting syndromes back to the DP8400. Therefore, by being able to read the externally stored syndromes, the microprocessor can monitor or store the syndromes whenever needed.

Mode 2 transfers system data from the higher byte into CIL, instead of DIL, to simulate check bits. This can be used in three ways. First, as shown in *Figure 5b*, the simulated check bits can be latched in CIL by taking CSLE low. If the DP8400 is now set to normal read, mode 4, and new data is presented then, provided DLE is high and CSLE is kept low.

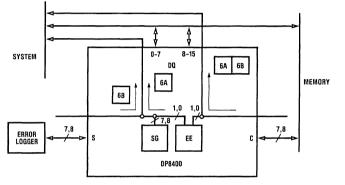
the DP8400 will perform a normal read operation as if it were reading memory check bits. The results of this simulated read may be checked by enabling DOL to see if an error (if inserted) was corrected. Or as a further check, by entering mode 6, the predicted generated syndromes and error flags may be checked. Second, also while in mode 2, the simulated check bits appear at the check bit port (from the data bus higher byte) available to be written to the check bit portion of memory as shown in *Figure 4c*. OLE is set high before the original simulated check bits are removed and then memory data is subsequently placed on the data bus. A write to memory will now write known data and simulated check bits to the selected location. By writing known data to the memory check bits in mode 2, and then reading the memory check bits in mode 6, each check bit in each location can be validated. Third, it is possible in mode 2 with OES low to transfer data from the higher byte to the syndrome I/O port, also shown in Figure 5c. But first the generated check bits must be all low. This is attained by previously loading all "1"s into DIL in an earlier cycle. This is useful when using an error logger in conjunction with the DP8400 to feed the syndrome word into the logger whenever an error occurs

# ERROR LOGGING WITH SYNDROME INJECTION CAPABILITY

An important application of the dedicated syndrome I/O port is for error logging. This is because the internally generated syndromes derived during reading are available on this port, provided  $\overline{OES}$  is set low. These syndromes indicate the exact location of a single error, whether it is in the data bits or check bits; they are therefore useful to be stored for error logging. Every time an error occurs when indicated by error flag AE, the syndromes corresponding to this error can be logged.

The syndrome word can be fed from SOL via the Syndrome Output Buffer onto the external syndrome bus. An Error Logger connected to this bus, as shown in *Figure 6*, will store the syndrome word in the same location as the corresponding address of each error that ocurs. An intelligent error logger will differentiate between new errors and ones that have occurred previously, by logging only new errors and ignoring ones that have already occurred. An easy way to determine this would be to compare the incoming memory address with the address of errors contained in the logger. If a match is not found and an error occurs, the new address and corresponding syndromes are logged. If a match is found, then whether an error occurs or not, no further action is necessary. Tag bits may be provided to indicate whether the error is hard or soft.

For example, if an error has already been logged at a particular address and that address is re-written to, then if the error repeats subsequently, it is a hard error, and if not, it is a soft error. So, if a tag bit is set when a write occurs to a previously logged address and a subsequent error is detected at that address, a second tag bit is set indicating a hard error. A better approach would be to have the DP8400 correct and rewrite to the same location all in the same cycle, as soon as a single error is detected. The first error detected in a location is classified as a soft error until it recurs, and if an error does recur, a tag bit is set to indicate a hard error. It is assumed here that multiple soft errors will not occur in the same location. Now that the error logger contains error information, it is necessary for the microprocessor to retrieve it. The DP8400 makes this easy, because the external syndrome bus data can be transferred to the data bus as described for operation in mode 6. If the error logger is made capable of outputting stored syndromes, and subsequently outputting the corresponding address one byte at a time, then all the relevant information can be retrieved by the microprocessor. The user may choose to store this in nonvolatile memory in the event of a power failure. When power returns, it will be desirable to restore this information back to the error logger, and this can be achieved by first loading DIL with all "1"s to create all generated check bits low. Now the addresses and syndromes can be loaded from the higher byte of the microprocessor through the syndrome I/O port one byte at a time, with DP8400 in mode 2, to the error logger.



TL/F/5032-9

FIGURE 5a. Read Internal Generated Syndromes and Check Bit Port (Mode 6A) or Read Syndrome Port and Check Bit Port (Mode 6B)

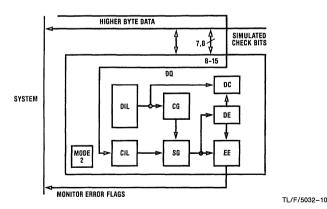


FIGURE 5b. Diagnostic Read – Compare Simulated Check Bits with Check Bits Generated from Data Stored in Previous Cycle AN-306

HIGHER BYTE DATA 7,8 8-15 SYSTEM no ALL '1' MEMORY ALL '0' DIL CG C s MODE 7.8 DP8400 2 TL/F/5032-11 1) DIAGNOSTIC WRITE: WRITE HIGHER DATA BYTE 2) TRANSFER HIGHER DATA BYTE TO SYNDROME TO CHECK BIT BUS (MODE 2) BUS (MODE 2, PREVIOUS CYCLE LATCHED ALL '1's IN DIL TO MAKE CG = 0) FIGURE 5c. DP8400: Mode 2 ADDRESS BUS DATA BUS DATA 16, 32, 64 ADDRESS TAG SYN SYSTEM E M O SYNDROMES CHECK BITS E<sup>2</sup>C<sup>2</sup> DP8400 16 6, 7, 8 6, 7, 8 **→2**> ERROR LOGGER TI /F/5032-12 FIGURE 6. Error Logger Connected to DP8400 Syndrome Port

# CORRECTING DOUBLE ERRORS USING THE ERROR LOGGER

AN-306

It is possible to take the error logging function one stage further. As described so far, the error logger has been storing single errors (data bit or check bit). What if a double error is detected? If it is detected without any previous history at that address, one solution would be to perform a Double Complement to attempt to correct both errors. If this is not done, no useful information can be obtained. If both errors are corrected, the error logger records the syndromes of both, and tags whether they were both hard, or one hard and one soft. But, if there is a previous history at this address of a single error, then it is fair to assume that the second error has subsequently occurred. In this case, if the error logger could be made to inject the syndromes of the first error into the DP8400, the DP8400 would correct this error so that its DOL would then contain data with one error (if both errors are data bit errors). It is necessary at this point to wrap-around DOL back to DIL and allow the DP8400 to correct the second error. This approach is much faster than the Double Complement approach and at the same time offers full error logging capability.

# ANY DOUBLE ERROR CORRECTION USING THE DOUBLE SYNDROME DECODE APPROACH

The data sheet shows how the DP8400 can perform double error correction using the Double Complement Approach. provided at least one of the errors was hard. For very large memories, this may not be adequate, as some systems will require total double error correction capability-quickly, without having to wait two additional memory cycles. Some of these systems will also require triple error detect capability. Fortunately, the matrix of the DP8400 has been configured to allow both of these capabilities. Most modern error detection/correction matrices use a modified version of Hamming's original code. The Hamming code allows single errors to be corrected, however, two errors may not be detected as such. For 16 data bits, five check bits are required. Modified Hamming codes allow double error detect capability, as well, by arranging that the Exclusive-OR of the syndrome words of any two bits in error produces an even parity syndrome word. A parity check on the syndrome bus will, therefore, indicate two errors (or no error, but in this case, the Any Error flag will be inactive). For 16 data bits, six check bits are required for single/double error detect and single error correction capabilities.

The DP8400 has a matrix that goes one step further by using a version of the Nelson code. This costs no additional on-chip gates to those required for a Modified Hamming code. To be able to correct any two errors, it is necessary to be able to determine their location, and no present version of the Modified Hamming code is able to do this. There are matrices that do exist that can generate 12 check bits from 16 data bits (or 14 check bits from 32 data bits) for writing, and then generate 12 (or 14) syndrome bits when reading. so that the location of both errors can be determined and corrected. But, because most applications do not require this degree of integrity and associated expense, they are not very popular. It would be ideal if two DP8400s could be configured as in Figure 7a, with each generating a different set of check bits and a different set of syndrome bits so that the double syndrome word could be unique and decodable for any two bits in error. Fortunately, National Semiconductor has achieved this by incorporating a feature called the Rotational Syndrome Word Generator, which uses rotated data to the secondary DP8400.

The primary DP8400 generates check bits when writing, and syndrome bits when reading, as in a normal 16-bit system. But the data port of the secondary DP8400 receives data shifted by a number of bits, usually one bit. In other words, for this secondary chip, system data bit 0 connects to DQ1, system data bit 1 to DQ2, etc. Each DP8400 has its own dedicated six memory check bits, which are obviously different from each other due to the data shifting on the secondary DP8400. The Nelson code is such that during a read, not only does each DP8400 generate a different set of syndrome bits, but the double syndrome word (comprising 12 bits for 16 data bits) is unique for any two bits in error. It is necessary to be able to output these syndromes as they occur and to do this, <u>DES</u> of both chips is set low during the time memory data is valid.

Now that we have a unique double syndrome word for any two bits in error, it is necessary to decode it to correct both errors. The easiest way to do this is to connect the double syndrome word to the address inputs of a registered PROM (a PROM with latchable data out) as shown in *Figure 7b*. In this example, 12 syndrome bits require 4k addressing capability, and 32k registered PROMs will be made available soon. Some of the address of the RPROM will be used for double errors and each address will be unique for any two

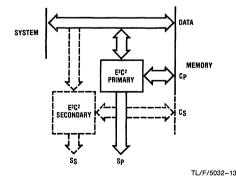


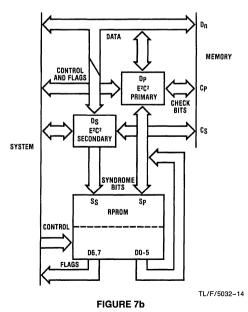
FIGURE 7a. 2 Different Generators

bits in error. The corresponding data out could, therefore, contain one of the syndrome words. Double errors may be caused by two data bit errors, a data bit and primary check bit error, a data bit and secondary check bit error, a primary and secondary check bit error, or two errors in either primary or secondary check bits. In these cases, if the RPROM address stores the syndrome word for one of the two errors, this will be available at the output of the RPROM when enabled.

First of all, this data must be latched in the RPROM register. and then the OES input to each DP8400 must be set high to deactivate the two syndrome output buffers. Next, the RPROM data must be enabled onto the primary syndrome bus so the primary DP8400 can enter this syndrome word, representing one of the two bits in error with CSLE high. At the same time, the primary DP8400 must be set to mode 7 so that the syndrome word appears on the internal syndrome bus, replacing the generated syndromes. If OLE is now set from low to high. DOL will contain either one or no error, depending on where the two errors were located. In other words, the DP8400 has just corrected one of the errors. By setting OLE low, then disabling memory and enabling OBO and OB1 of the primary DP8400, this data is output on the data bus and back into the DIL with DLE high. There is now only one data error, and this can be corrected by setting the DP8400 to normal read, mode 4.

Thus, both errors have been corrected at a fairly fast rate. For example, for a 50 ns RPROM, the total time to generate double syndromes, feed back a one-error syndrome word to the primary DP8400, correct it, wraparound, and correct again, may take less than 120 ns total.

Only a few of the addresses in the RPROM are required for double errors. Some double syndrome words represent single errors and triple errors. All single bit errors also produce a unique double syndrome word different from all double bit errors.



In fact, nearly all triple bit errors produce unique double syndrome words different from single and double bit errors. Those that do not produce unique double syndrome words, duplicate syndrome words of other single, double, and triple bit errors; however, these comprise only about 5 percent of the total. We can say, therefore, that this approach will correct not only all double bit errors, but will detect 95 percent of all triple bit errors. Note that with error correction systems utilizing the modified Hamming code, the majority of triple bit errors are interpreted as single bit errors and falsely corrected as such. It is up to the designer to determine the chances of three errors occurring in a memory location, and the (likely) consequences that they will be falsely corrected. If this condition is undesirable, then the Double Syndrome Decode Method offers greatly enhanced integrity; in fact, if the three errors detected do have a unique double syndrome word, they can be corrected. As stated, no presently used Modified Hamming code offers a unique double svndrome word for multiple errors; this is only possible with a Nelson code. This example was largely for 16 data bits, but the idea will work for other data widths.

In the 16-bit example, the RPROM has to output only six bits representing the syndrome bits of a bit in error. This leaves two spare bits which can be used as flags, and the user can program his RPROM accordingly. One solution is to use these flags to indicate the type of action required—whether to correct at all, correct once, or correct twice by wrapping around.

#### **BLOCK DIAGRAM OF THE DP8400**

This Application Note discusses first the single error correction, showing a simplified block diagram of the chip for both a write cycle to generate check bits, and a read cycle to detect errors and correct single bit errors. The most important requirement when accessing memory is that these operations be performed with minimal memory delays. The DP8400, therefore, has been structured internally to minimize series propagation delays through the chip. A full block diagram of the DP8400 is shown, and first impressions are that there might be excessive delays in the various paths due to the additional blocks that have been added to the basic functional block diagram. In fact, this is not the case, because the DP8400 has been configured in bipolar Schottky logic and uses the AND-OR-INVERT gate in many of the blocks. This type of gate structure is used in multiplexers, Exclusive-OR gates and fall-through latches. It is possible, therefore, to combine these functions into one wide gate, reducing the propagation delays through some of these blocks to that of one gate. For example, the check bit output latch COL receives its input from an Exclusive-OR gate followed by a multiplexer. These three functions can be combined into one wide gate, and this greatly reduces the time taken to generate check bits.

#### THE DP8400—A VERSATILE ERROR CHECKER/ CORRECTOR FOR ALL APPLICATIONS

It was shown earlier how the DP8400 was able to detect single and double errors, and correct single errors. For 8and 16-bit systems, these could easily be accomplished with a minimum of extra circuitry. The DP8400 can also be used in complex high integrity systems. In fact, investigations are still progressing as to its immense capabilities. It is the only error correction circuit capable of these features, and yet it still provides very fast throughput. For these reasons, the DP8400 should become the industry standard error correction chip for the foreseeable future.

# DP8400s in 64-Bit Expansion

National Semiconductor Application Note 308 Chuck Pham



The purpose of this Application Note is to provide memory designers with detailed information on the DP8400 parallel expansion method. This method allows fast check bit generation, error detection, and error correction. A thorough understanding of the 16-bit implementation is a prerequisite. Included in this note are the following: error correction expansion matrix; detailed steps for check bit generation, error detection and error correction; an example of a single error configuration.

# The Error Correction Expansion Matrix

For a 16-bit word, the DP8400 reads data between the processor and memory, with its 16-bit bidirectional data bus connected to the memory data bus. The DP8400 uses an encoding matrix to generate six check bits from the 16 bits of data. This 16-bit matrix contains 16 unique syndrome patterns corresponding to each error location which allows the DP8400's Data Error Decoder (DED) to identify the data error location.

The DP8400 is easily expandable to other data configurations. For a 32-bit data word with seven check bits, two DP8400s are used. Three DP8400s can be used for 48 bits. four DP8400s for 64 bits, and five DP8400s for 80 bits, all with eight check bits. In order to expand the DP8400, additional check bits are required to provide the unique characteristic of the single data error syndrome. For expansion beyond 24 bits, check bits 6 and 7 (C6 and C7) are used. Note that these check bits can be configured to be always either zero or word parity, depending on the input voltage level of the Expansion Pin (XP). By rearranging all eight check bits (C0-C7) of each DP8400, we can obtain many different matrices that meet the above requirement. One of these is shown in Table I. For illustration, this matrix will be used throughout this application note to clarify the E2C2 expansion concept.

# Check Bit Generation, Error Detection And Error Correction

#### CHECK BIT GENERATION (Figure 1)

In the Check Bit Generation mode, all four DP8400s are set to mode 0, normal write. The 64 bits of data from the system data bus are enabled into the Data Input Latches (DIL) of each DP8400. The individual Check Bit Generation (CG) of the four DP8400s then produce eight parity bits, or partial check bits, derived from the input data. (Note that all the syndrome input latches should be cleared so that only the partial check bits will pass through the Check Bit Output Latches/Buffers (COL and COB). In the normal write mode, the COBs are always enabled onto each check bit port. This allows the partial check bits to be combined externally in

#### TABLE I. Data Bit Error to Syndrome-Generate Matrix, 64-Bit Configuration

The partial code of device 0:

| THE | : ha | <b>a</b> i (1 |   |   |   |   |   |   |   | Data | Bit | Nun | nbe | rs) |    |    |
|-----|------|---------------|---|---|---|---|---|---|---|------|-----|-----|-----|-----|----|----|
| 0   | 1    | 2             | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10   | 11  | 12  | 13  | 14  | 15 |    |
| 0   | 0    | 1             | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1    | 1   | 0   | 1   | 1   | 1  | C0 |
| 0   | 0    | 0             | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0    | 1   | 0   | 1   | 1   | 1  | C1 |
| 1   | 0    | 0             | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1    | 0   | 1   | 1   | 1   | 1  | C2 |
| 0   | 1    | 1             | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1    | 0   | 1   | 0   | 1   | 1  | СЗ |
| 1   | 1    | 0             | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0    | 1   | 0   | 1   | 0   | 1  | C4 |
| 1   | 1    | 1             | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0    | 0   | 1   | 1   | 1   | 0  | C5 |
| 0   | 0    | 0             | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0    | 0   | 0   | 0   | 0   | 0  | C6 |
| 0   | 0    | 0             | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0    | 0   | 0   | 0   | 0   | 0  | C7 |

#### The partial code of device 1:

|    |    |    |    |    | _  |    |    |    |    |    | -  |    |    | _  | _  |    |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 |    |
| 0  | 0  | 0  | 1  | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 1  | 0  | 1  | 1  | 1  | C1 |
| 1  | 1  | 1  | 0  | 1  | 1  | 1  | 0  | 1  | 0  | 0  | 0  | 1  | 1  | 1  | 0  | C5 |
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | C6 |
| 1  | 1  | 0  | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 0  | 1  | 0  | 1  | 0  | 1  | C4 |
| 0  | 1  | 1  | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 0  | 1  | 0  | 1  | 1  | СЗ |
| 1  | 0  | 0  | 1  | 1  | 0  | 0  | 0  | 1  | 0  | 1  | 0  | 1  | 1  | 1  | 1  | C2 |
| 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 0  | 1  | 1  | 1  | 0  | 1  | 1  | 1  | C0 |
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | C7 |
|    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |

#### The partial code of device 2:

| 32 | 33 | 34 | 35 | 36 | 37 | 38 | 39 | 40 | 41 | 42 | 43 | 44 | 45 | 46 | 47 |    |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | C6 |
| 0  | 1  | 1  | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 0  | 1  | 0  | 1  | 1  | СЗ |
| 1  | 1  | 1  | 0  | 1  | 1  | 1  | 0  | 1  | 0  | 0  | 0  | 1  | 1  | 1  | 0  | C5 |
| 1  | 1  | 0  | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 0  | 1  | 0  | 1  | 0  | 1  | C4 |
| 1  | 0  | 0  | 1  | 1  | 0  | 0  | 0  | 1  | 0  | 1  | 0  | 1  | 1  | 1  | 1  | C2 |
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | C7 |
| 0  | 0  | 0  | 1  | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 1  | 0  | 1  | 1  | 1  | C1 |
| 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 0  | 1  | 1  | 1  | 0  | 1  | 1  | 1  | C0 |

The partial code of device 3:

| 48 | 49 | 50 | 51 | 52 | 53 | 54 | 55 | 56 | 57 | 58 | 59 | 60 | 61 | 62 | 63 |    |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| 1  | 1  | 0  | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 0  | 1  | 0  | 1  | 0  | 1  | C4 |
| 1  | 1  | 1  | 0  | 1  | 1  | 1  | 0  | 1  | 0  | 0  | 0  | 1  | 1  | 1  | 0  | C5 |
| 0  | 1  | 1  | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 0  | 1  | 0  | 1  | 1  | СЗ |
| 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | C6 |
| 1  | 0  | 0  | 1  | 1  | 0  | 0  | 0  | 1  | 0  | 1  | 0  | 1  | 1  | 1  | 1  | C2 |
| 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 0  | 1  | 1  | 1  | 0  | 1  | 1  | 1  | C0 |
| 0  | 0  | 0  | 1  | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 1  | 0  | 1  | 1  | 1  | C1 |
| _1 | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | C7 |

## Check Bit Generation, Error Detection And Error Correction (Continued)

the eight 74S280s' parity generators/checkers to produce eight composite check bits. Table II. shows how these check bits are generated.

#### Table II. Composite Check Bits Generation

| Ccomp. $0 = C(0)0 \oplus C(1)1 \oplus C(2)6 \oplus C(3)4$ |  |
|-----------------------------------------------------------|--|
| Ccomp. 1 = C(0)1 ⊕ C(1)5 ⊕ C(2)3 ⊕ C(3)5                  |  |
| Ccomp. $2 = C(0)2 \oplus C(1)6 \oplus C(2)5 \oplus C(3)3$ |  |
| $Ccomp. 3 = C(0)3 \oplus C(1)4 \oplus C(2)4 \oplus C(3)6$ |  |
| Ccomp. $4 = C(0)4 \oplus C(1)3 \oplus C(2)2 \oplus C(3)2$ |  |
| Ccomp. 5 = C(0)5 ⊕ C(1)2 ⊕ C(2)7 ⊕ C(3)0                  |  |
| $Ccomp. 6 = C(0)6 \oplus C(1)0 \oplus C(2)1 \oplus C(3)1$ |  |
| Ccomp. 7 = C(0)7 ⊕ C(1)7 ⊕ C(2)0 ⊕ C(3)7                  |  |
|                                                           |  |

#### Notes:

Ccomp: composite check bit.

C(X)N: the partial check bit N of device X.

(Refer to Table I. for clarification).

To aid in fast error detection during memory read cycles, these composite check bits are complemented and written into memory along with the system data. If the system data has vacated the data bus, the Output Enables ( $\overline{OB0}$  and  $\overline{OB1}$ ) must be set low so that the original data word with its eight composite check bits can be written into memory.

#### **DETECTION MODE (Figure 2)**

In the Detection mode, again all the DP8400s are set to mode 0, normal write, then the partial check bits derived from the memory data bits are generated in a manner similar to that described for the check bit generation mode. These partial check bits are then associatively compared with the memory check bits in the eight 74S280s to produce eight external Composite Syndrome bits. As explained in the check bit generation mode, the composite check bits are complemented before being written into memory. This shows why complemented Composite Syndrome bits are produced instead of true composite syndromes. Then, if any bits on the Composite Syndrome bus go low, this will cause the 74S30 NAND gate to go high, giving the Any Error indication. If there is no error, all Composite Syndrome bits remain high. These Syndrome bits are also latched into the 74ALS533 Octal D-type Transparent Latch (with inverted output). The composite syndromes are then fed into the syndrome ports of the DP8400s in different combinations for each, for error-type determination and/or error correction.

#### CORRECTION MODE: (Figure 3)

Upon receiving the Any Error indication during the detection mode, it takes an additional step to determine the error type and to correct a single data error. All the DP8400s should be set to mode 7B (which is mode 7 with  $\overline{\text{OES}}$  high), this mode enables the external syndromes directly to the Syndrome Generator (SG) and then the Data Error Decoder (DED) of each chip. For a single data error, the input syndrome will be unique for that error location; consequently, only one DP8400 can decode that error location and correct that bit. The other three do not indicate an error and do not change their data output latch contents. This corrected data can be output to the system data bus by means of  $\overline{OB0}$  and  $\overline{OB1}$ . The DP8400 that decodes the data error location will indicate a single data error, while all others indicate a check

bit error. If there was a single check bit error or a double bit error, then all the DP8400s will indicate a check bit error or a double bit error, respectively, through their error flags.

# AN EXAMPLE OF A SINGLE DATA ERROR CORRECTION

Assuming all zero data is to be written into memory, we obtain the following set of partial check bits for all DP8400s:

| C0 = 0 | C4 = 0 |
|--------|--------|
| C1 = 0 | C5 = 0 |
| C2 = 1 | C6 = 0 |
| C3 = 1 | C7 = 0 |

Note that each DP8400 contains the basic 16-bit matrix (C0—C5). Therefore, the first six partial check bits are the same for all devices; only C6 and C7 are different. With the 64-bit configuration using the above 64-bit matrix, C6 = C7 = 0 (by connecting XP directly to V<sub>CC</sub>) for the devices 0, 1, and 2; and C6 = C7 = word parity (by leaving XP pin floating) for the device 3. However, with all zero data, word parity is also zero (even parity). Therefore, the above partial check bits are obtained.

Using the formulas given in Table II, the composite check bits are as follows:

| $Ccomp. 0 = 0 \oplus 0 \oplus 0 \oplus 0 = 0$        |
|------------------------------------------------------|
| Ccomp. $1 = 0 \oplus 0 \oplus 1 \oplus 0 = 1$        |
| Ccomp. $2 = 1 \oplus 0 \oplus 0 \oplus 1 = 0$        |
| $\text{Ccomp. 3} = 1 \oplus 0 \oplus 0 \oplus 0 = 1$ |
| Ccomp. $4 = 0 \oplus 1 \oplus 1 \oplus 1 = 1$        |
| $Ccomp.5=0\oplus1\oplus0\oplus0=1$                   |
| $Ccomp.6=0\oplus0\oplus0\oplus0=0$                   |
| Ccomp. $7 = 0 \oplus 0 \oplus 0 \oplus 0 = 0$        |

Note that these composite check bits are complemented before they are written into memory. Thus, the memory check bits read later from memory are 1100 0101.

If an error has occurred in the data position 35 which is bit 3 of device 2, then the partial check bits C(3) N produced during the detection mode are as follows:

| C(3)0 = 1 | C(4) = 0 |
|-----------|----------|
| C(3)1 = 1 | C(5) = 0 |
| C(3)2 = 0 | C(6) = 0 |
| C(3)3 = 1 | C(7) = 0 |
|           |          |

The partial check bits of other devices are unchanged. Consequently, the newly generated composite check bits (Ccomp) and the total syndrome bits are:

| Bit # | Newly Generated<br>Composite<br>Check Bits |   | Memory<br>Check Bits |   | Composite<br>Syndrome |
|-------|--------------------------------------------|---|----------------------|---|-----------------------|
| 0     | 0                                          | ⊕ | 1                    | = | 1                     |
| 1     | 1                                          | ⊕ | 0                    | = | 1                     |
| 2     | 0                                          | ⊕ | 1                    | = | 1                     |
| З     | 1                                          | ⊕ | 0                    | = | 1                     |
| 4     | 0                                          | ⊕ | 0                    | = | 0                     |
| 5     | 1                                          | ⊕ | 0                    | = | 1                     |
| 6     | 1                                          | ⊕ | 1                    | = | 0                     |
| 7     | 1                                          | ⊕ | 1                    | = | 0                     |

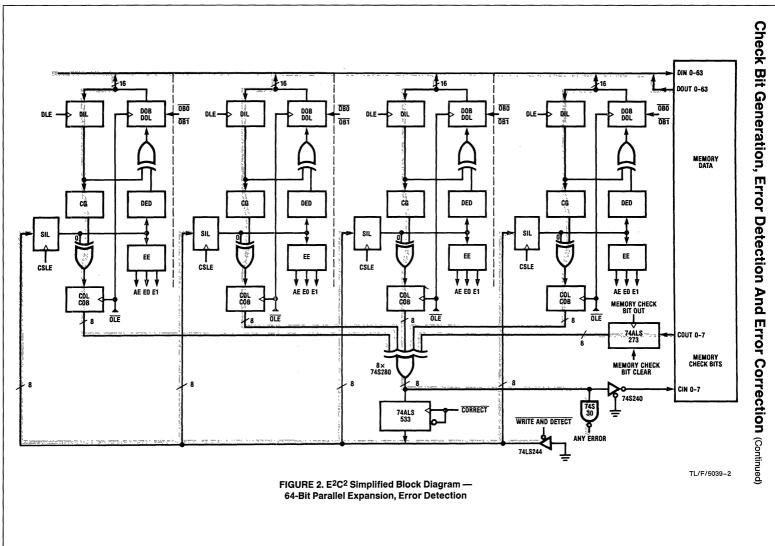
Check Bit Generation, Error Detection And Error Correction (Continued) DIN 0-63 16 - 16 16 16 DOUT 0-63 OBO OB1 OBO **OBO OBO** DOB DOL DOB DOL DOB DOL DOB DOL DLE DLE DLE OLE -DIL DIL OBI OB1 0B1 MEMORY Data CQ DED Cß DED CG DED CG, DED SIL SIL SIL SIL 9 9 <u>9</u> 9 I EE EE EE EE CSLE CSLE CSLE CSLE AE ED E1 AE EO E1 **↓** ↓ ↓ \* \* \* AE EO E1 AE EO E1 COL COB COL COB COL COB COL COB MEMORY CHECK BIT OUT ŌLE ŌLE OLE 18 18 8 8 74ALS 273 COUT 0-7 MEMORY CHECK BITS 8× 74\$280 MEMORY CHECK BIT CLEAR 8 CIN 0-7 74\$240 74S 30 CORRECT 74ALS 533 ÷ WRITE AND DETECT ANY ERROR 74LS244 ÷ TL/F/5039-1 FIGURE 1. E<sup>2</sup>C<sup>2</sup> Simplified Block Diagram— 64-bit Parallel Expansion, Check-Bit Generation

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N

806-NA

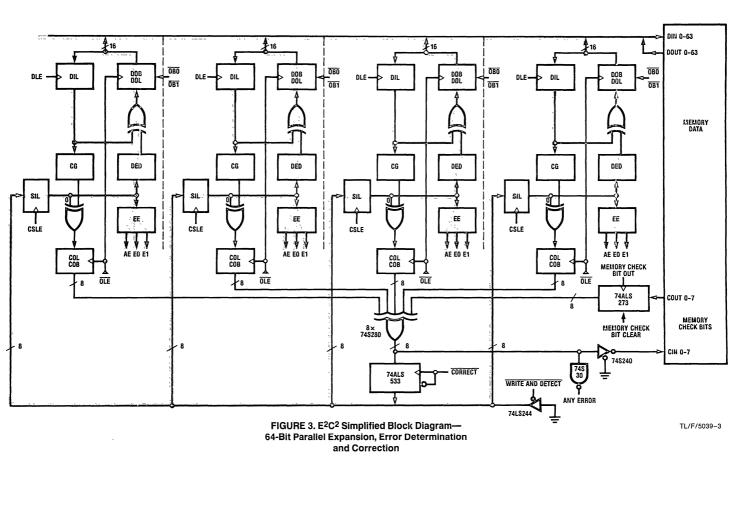
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Check Bit Generation, Error Detection And Error Correction (Continued)



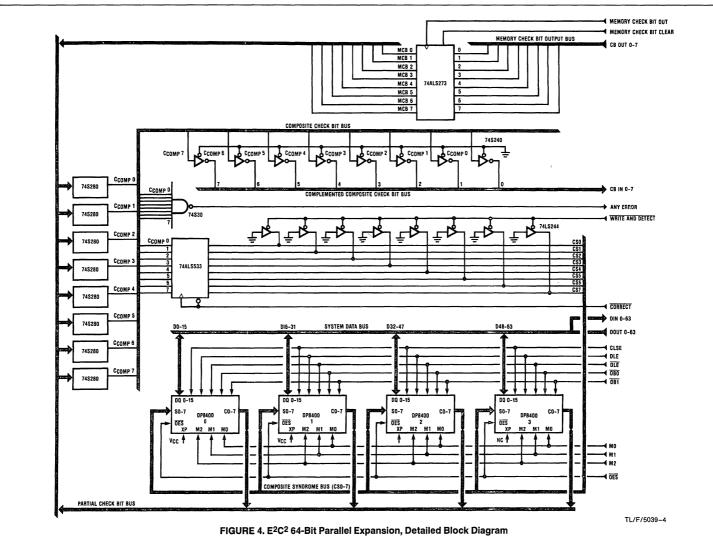
80E-NA

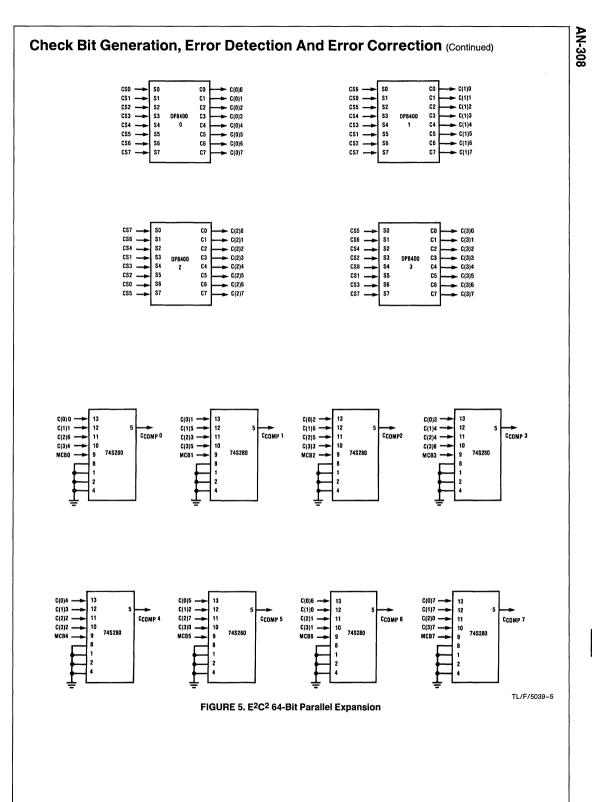
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Check Bit Generation, Error Detection And Error Correction (Continued)



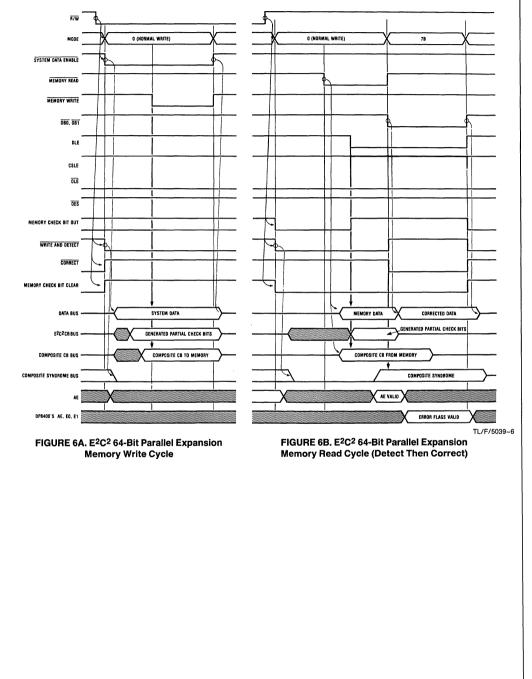


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# Check Bit Generation, Error Detection And Error Correction (Continued)

The composite syndrome 11010000 is that of the error location 35. Since the syndrome is unique and fed reordered to each DP8400, only device 2 will recognize this syndrome pattern and complement its data bit 3. Then the corrected data can be output to the system data bus when  $\overline{OB0}$  and OB1 of all four DP8400s go low. Devices 0, 1, and 3 all output the same data they received from memory. Only device 2 changes its (erroneous) data. Refer to *Figure 6* below for the timing diagrams of a memory write and memory read cycle (detect then correct).





Section 3 Microprocessor Applications for the DP8408A/09A/17/ 18/19/28/29

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# **Section 3 Contents**

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# **Selection Guide**

One of the great strengths of the DP8400 DRAM Interface Family is its General purpose open-architecture approach. Applications and hardware support for all the major 8-, 16-, and 32-bit microprocessors (not just National's) are provided through the DP84XX2 Family. Each of these devices has been tailored to provide a general purpose but efficient interface between the DP8409A, 8417, 8418, 8419, 8428, 8429 DRAM controller/drivers and each of the major cpu's. Each device uses a 20 pin standard PAL device such as the PAL16R4A as its building block. Programming equations have been written and hard programmed into each device which supply all the control signals needed to perform memory read, write, refresh, and arbitration. In order to allow for system customization, the programming equations for each device are printed in each data sheet.

#### Microprocessor to DRAM Controller Interface a SELECTION GUIDE

| Device # | Microprocessor           | DRAM Cont./                 | Max. Pro | op Delay | Vcc      | Тур.   | Process                  | Operating | Dackana   | Page |
|----------|--------------------------|-----------------------------|----------|----------|----------|--------|--------------------------|-----------|-----------|------|
| Device # | Supported                | Drivers Supported           | "A" PAL  | "B" PAL  | VCC      | Icc    | FIGCESS                  | Temp.     | rackaye   | No.  |
| DP84412  | NS32008/16/32            | DP8409A, 17, 18, 19, 28, 29 | 25 ns    | 15 ns    | +5V ±10% | 120 mA |                          | 0°-70°C   | 20J, N, V | 3-24 |
| DP84512  | NS32332                  | DP8417, 18, 19, 28, 29      | 25 ns    | 15 ns    | +5V ±10% | 120 mA |                          | 0°-70°C   | 20J, N, V | 3-64 |
| DP84322  | 68000/08/10<br>(≤10 MHz) | DP8409A, 17, 18, 19, 28, 29 | 25 ns    | 15 ns    | +5V ±10% |        | Junction<br>Isolated (S) |           | 20J, N, V | 3-9  |
| DP84422  | 68000/08/10<br>(≥10 MHz) | DP8409A, 17, 18, 19, 28, 29 | 25 ns    | 15 ns    | +5V ±10% | 120 mA | Oxide                    | 0°–70°C   | 20J, N, V | 3-37 |
| DP84522  | 68020                    | DP8417, 18, 19, 28, 29      | 25 ns    | 15 ns    | +5V ±10% | 120 mA | Isolated<br>(ALS)        | 0°-70°C   | 20J, N, V | 3-65 |
| DP84432  | 8086/88/186/188          | DP8409A, 17, 18, 19, 28, 29 | 25 ns    | 15 ns    | +5V ±10% | 120 mA |                          | 0°-70°C   | 20J, N, V | 3-51 |
| DP84532  | 80286                    | DP8409A, 17, 18, 19, 28, 29 | 25 ns    | 15 ns    | +5V ±10% | 120 mA |                          | 0°-70°C   | 20J, N, V | 3-81 |

# PRELIMINARY

# **DP84300 Programmable Refresh Timer**

### **General Description**

National Semiconductor

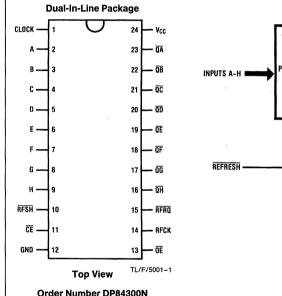
The DP84300 programmable refresh timer is a logic device which produces the desired refresh clock required by all dynamic memory systems.

Additional circuitry has been included in the device to minimize logic required by memory systems to perform refresh control.

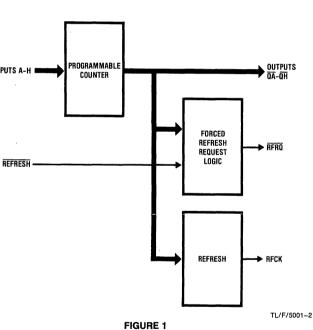
### **Features**

- One chip solution to produce RFCK timing for the DP8408A, DP8409A, DP8417, DP8418, DP8419, DP8428, DP8429 dynamic RAM controllers
- Programmable refresh clock timer allows for a maximum refresh period with most system clocks
- Timing is completely synchronous with the input clock, preventing race conditions present in some memory controllers
- Includes a refresh request output, simplifying the design of refresh logic in discrete controllers

# **Connection & Block Diagrams**







| Recommended Operating Conditions (Commercial)               |        |       |        |         |                                                                                   |     |     |     |       |  |  |
|-------------------------------------------------------------|--------|-------|--------|---------|-----------------------------------------------------------------------------------|-----|-----|-----|-------|--|--|
| If Military/Aerospace specif                                | ied de | vices | are re | quired, |                                                                                   | Min | Тур | Max | Units |  |  |
| please contact the Nation<br>Office/Distributors for availa |        |       |        |         | I <sub>OL</sub> , Low Level Output Current<br>T <sub>A</sub> , Operating Free Air |     |     | 16  | mA    |  |  |
|                                                             | Min    | Тур   | Max    | Units   | Temperature                                                                       | 0   |     | 75  | °C    |  |  |
| V <sub>CC</sub> , Supply Voltage                            | 4.75   | 5.00  | 5.25   | V       |                                                                                   |     |     |     |       |  |  |
| IOH, High Level Output Current                              |        |       | -3.2   | mA      |                                                                                   |     |     |     |       |  |  |

| Electrical Characteristics | over recommended operating temperature range |
|----------------------------|----------------------------------------------|
|----------------------------|----------------------------------------------|

IOH, High Level Output Current

| Symbol           | Parameter                                              | Conditions                                                        | Min | Тур | Max   | Units |
|------------------|--------------------------------------------------------|-------------------------------------------------------------------|-----|-----|-------|-------|
| ViH              | High Level Input Voltage                               |                                                                   | 2   |     |       | V     |
| VIL              | Low Level Input Voltage                                |                                                                   |     |     | 0.8   | ٧     |
| V <sub>IC</sub>  | Input Clamp Voltage                                    | $V_{CC} = Min$ , $I_I = -18 \text{ mA}$                           |     |     | -1.5  | v     |
| V <sub>OH</sub>  | High Level Output Voltage                              | $V_{CC} = Min$ , $V_{IH} = 2V$ , $V_{IL} = 0.8V$ , $I_{OH} = Max$ | 2.4 |     |       | v     |
| V <sub>OL</sub>  | Low Level Output Voltage                               | $V_{CC} = Min$ , $V_{IH} = 2V$ , $V_{IL} = 0.8V$ , $I_{OL} = Max$ |     |     | 0.5   | ٧     |
| lozh             | Off-State Output Current<br>High Level Voltage Applied | $V_{CC} = Max, V_{IH} = 2V, V_O = 2.4V, V_{IL} = 0.8V$            |     |     | 100   | μΑ    |
| I <sub>OZL</sub> | Off-State Output Current<br>Low Level Voltage Applied  | $V_{CC} = Max, V_{IH} = 2V, V_O = 0.4V, V_{IL} = 0.8V$            |     |     | - 100 | μΑ    |
| կ                | Input Current at<br>Maximum Input Voltage              | $V_{CC} = Max, V_I = 5.5V$                                        |     |     | 1.0   | mA    |
| IIH              | High Level Input Current                               | $V_{CC} = Max, V_I = 2.4V$                                        |     |     | 25    | μA    |
| ί <sub>IL</sub>  | Low Level Input Current                                | $V_{CC} = Max, V_I = 0.4V$                                        |     |     | -250  | μA    |
| los              | Short Circuit Output Current                           | V <sub>CC</sub> = Max                                             | -30 |     | -130  | mA    |
| ICC              | Supply Current                                         | V <sub>CC</sub> = Max                                             |     | 150 | 180   | mA    |

# DP84300 Switching Characteristics over recommended ranges of temperature and V<sub>CC</sub>

| Symbol           | Paramete                 | r                       | Conditions<br>$R_L = 667\Omega$ | T <sub>A</sub><br>V | Units |     |     |
|------------------|--------------------------|-------------------------|---------------------------------|---------------------|-------|-----|-----|
|                  |                          |                         |                                 | Min                 | Тур   | Max |     |
| t <sub>PD</sub>  | Clock to Output          |                         | $C_{1} = 45  \text{pF}$         |                     | 35    | 50  | ns  |
| t <sub>PZX</sub> | Pin 13 to Output Er      | able                    |                                 |                     | 20    | 35  | ns  |
| t <sub>PXZ</sub> | Pin 13 to Output Disable |                         | $C_L = 5  pF$                   |                     | 20    | 35  | ns  |
| t <sub>PZX</sub> | Input to Output Enable   |                         | $C_L = 45  pF$                  |                     | 35    | 45  | ns  |
| t <sub>PXZ</sub> | Input to Output Disa     | Input to Output Disable |                                 |                     | 35    | 45  | ns  |
| tw               | Width of Clock           | High                    |                                 | 25                  |       |     | ns  |
|                  |                          | Low                     |                                 | 35                  |       |     | ns  |
| t <sub>SU</sub>  | Set-Up Time              |                         |                                 | 50                  |       |     | ns  |
| t <sub>H</sub>   | Hold Time                |                         |                                 | 0                   | - 15  |     | ns  |
| fMAX             | Maximum Frequend         | cy                      |                                 | 12.5                |       |     | MHz |

DP84300

## **Mnemonic Description**

#### INPUT SIGNALS

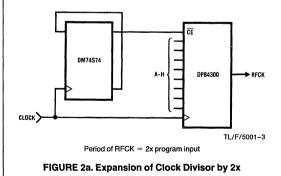
- CLOCK Provides a time base for the programmable divider.
- A-H Program inputs A through H. These inputs select the number of clock cycles that will produce one refresh period. These inputs are binary encoded, with input A the LSB, and H the MSB. Additionally, all zeros produce the maximum count of 256, and an input of one will reset the counter to one.
- REFRESH This input is used to reset the refresh request output (RFRQ).
- OE Output enable. Places the outputs in TRI--STATE®.
- CE Counter enable. This input, when low, enables the timer clock and, when high, stalls the timer.

#### OUTPUT SIGNALS

- QA-QH
   Refresh timer outputs QA through QH. Timer starts at programmed input and counts down to one.
- RFRQ Refresh request. This output goes low on the rising edge of the refresh clock (RFCK). The first input clock edge after the REFRESH input is set low clears this output.
- RFCK Refresh clock. The period of the clock is determined by setting conditions on input pins A through H. This output is low for 20 clocks, and high for the remainder of the period.

### **Functional Description**

The DP84300 block diagram is shown in *Figure 1*. This circuit is basically an 8-bit programmable counter. The user selects the number of input clock cycles required per refresh period and sets the binary equivalent on inputs A through H. A signal of that period is produced at the refresh clock (RFCK) output. This output stays low for 20 clock cycles, and goes high for the balance of the period.



When used with the DP8409A dynamic RAM controller, this duty cycle allows the DP8409A the maximum probability to perform a hidden refresh, while still allowing ample time for the DP8409A to perform a forced refresh when needed.

An additional output is provided to ease the design of systems that don't use the DP8409A. This output is called refresh request ( $\overline{RFRQ}$ ). Refresh request becomes true at the rising edge of refresh clock, and becomes false on the first rising edge of the input clock after a refresh.

In systems where a divisor of more than 256 is needed, an expansion input ( $\overline{CE}$ ) has been provided. When this input is high, all counter-related timing is suspended. This excluded actions due to the REFRESH input. The circuits in *Figures 2a* and *2b* show how to expand the range of the timer by 2x or by up to 4096 clock cycles. *Figures 3a* and *3b* show two typical applications using the DP84300.

By using the clock enable input, it is also possible to change the duty cycle of the refresh clock. The circuits in *Figures 4a* and *4b* show how this may be done.

To reset the counter to a known state, select an input divisor of one. On the next clock edge the counter will reset to one. On the next clock edge whatever input divisor that is present on input A-H will be loaded into the counters.

TABLE I. Divider Constants for Generation of a 15.5  $\mu s$  Clock

| CPU Clock<br>Frequency | Divisor<br>Input | Actual Period<br>of Output | % Chance of<br>Hidden Refresh |
|------------------------|------------------|----------------------------|-------------------------------|
| 2 MHz                  | 31               | 15.5 μs                    | 35%                           |
| 3 MHz                  | 46               | 15.3 μs                    | 56%                           |
| 4 MHz                  | 62               | 15.5 μ <b>s</b>            | 67%                           |
| 5 MHz                  | 77               | 15.6 μs                    | 74%                           |
| 6 MHz                  | 93               | 15.5 μ <b>s</b>            | 78%                           |
| 7 MHz                  | 109              | 15.6 μs                    | 81%                           |
| 8 MHz                  | 124              | 15.5 μs                    | 83%                           |
| 9 MHz                  | 140              | 15.6 μs                    | 85%                           |
| 10 MHz                 | 155              | 15.5 μs                    | 87%                           |

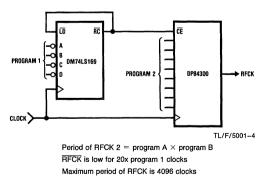
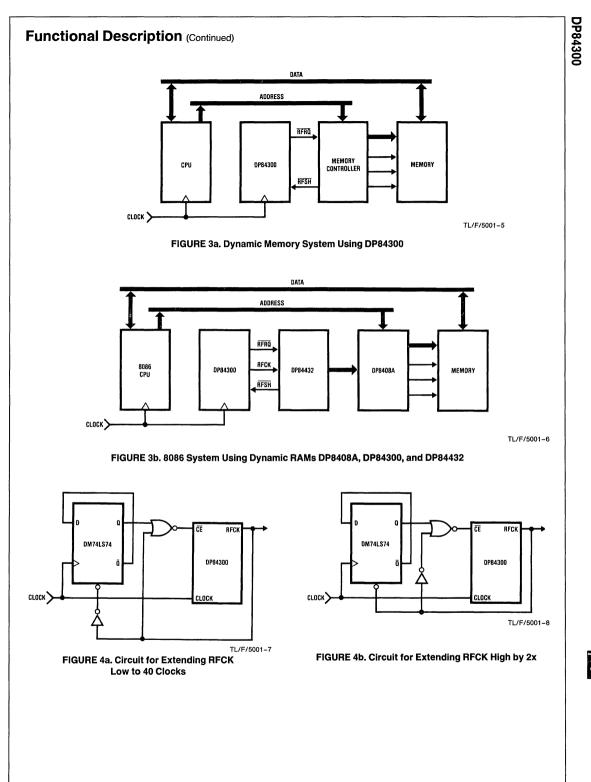
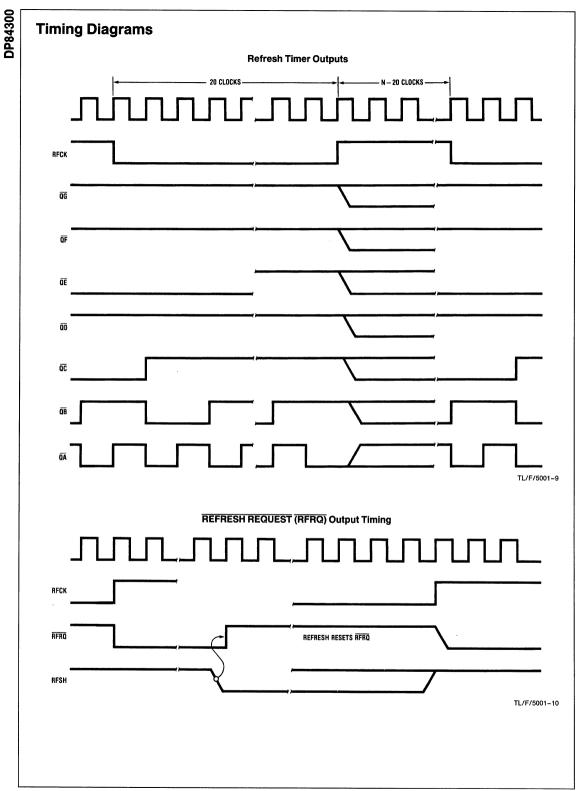


FIGURE 2b. Typical Expansion for the DP84300







## DP84322 Dynamic RAM Controller Interface Circuit for the 68000 CPU

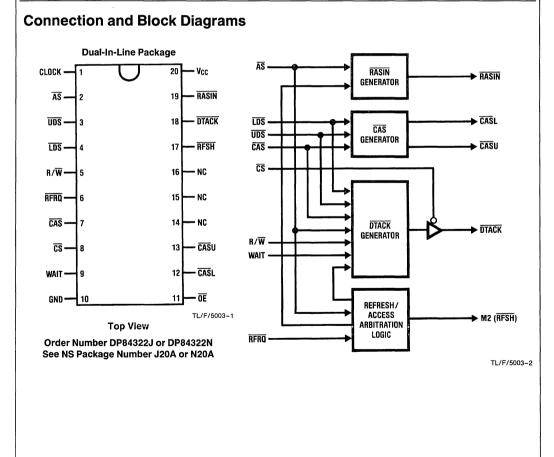
### **General Description**

The DP84322 dynamic RAM controller interface is a Programmable Array Logic (PAL®) device which allows for easy interface between the DP8409A, 17, 18, 19, 28, 29 dynamic RAM Controllers and the 68000/008/010 microprocessors.

The DP84322 supplies all the control signals needed to perform memory read, write and refresh. Logic is included for inserting a wait state when using fast CPUs.

#### Features

- Provides 3-chip solution for the 68000 CPU and dynamic RAM interface (DP84300, DP84322, & DP8409A)
- Works with all 68000 speed versions
- Possibility of operation at 8 MHz with no wait states
- Performs hidden refresh
- DTACK is automatically inserted for both memory access and memory refresh
- Performs forced refresh using typically 4 CPU clocks
- Standard National Semiconductor PAL part (DMPAL16R4)
- PAL logic equations can be modified by the user for his specific application and programmed into any of the PAL in the National Semiconductor PAL family, including the new high speed PALs.



## **Recommended Operating Conditions** (Commercial) If Military/Aerospace specified devices are required,

please contact the National Semiconductor Sales Office/Distributors for availability and encettion

| Office/Distributors for availability and specifications. |      |      |         |       |  |  |  |
|----------------------------------------------------------|------|------|---------|-------|--|--|--|
|                                                          | Min  | Тур  | Max     | Units |  |  |  |
| V <sub>CC</sub> , Supply Voltage                         | 4.75 | 5.00 | 5.25    | v     |  |  |  |
| IOH, High Level Output Current                           |      |      | -3.2    | mA    |  |  |  |
| I <sub>OL</sub> , Low Level Output Current               |      |      | 24      | mA    |  |  |  |
|                                                          |      |      | (Note 2 | )     |  |  |  |

#### Electrical Characteristics over recommended operating temperature range

| Symbol           | Parameter                                              | Conditions                                               | Min | Тур | Max    | Units |
|------------------|--------------------------------------------------------|----------------------------------------------------------|-----|-----|--------|-------|
| VIH              | High Level Input Voltage                               |                                                          | 2   |     |        | ٧     |
| VIL              | Low Level Input Voltage                                |                                                          |     |     | 0.8    | ٧     |
| VIC              | Input Clamp Voltage                                    | $V_{CC} = Min, I_I = -18 \text{ mA}$                     |     |     | -1.5   | ٧     |
| V <sub>OH</sub>  | High Level Output Voltage                              | $V_{CC} = Min, V_{IH} = 2V, V_{IL} = 0.8V, I_{OH} = Max$ | 2.4 |     |        | ٧     |
| V <sub>OL</sub>  | Low Level Output Voltage                               | $V_{CC} = Min, V_{IH} = 2V, V_{IL} = 0.8V, I_{OL} = Max$ |     |     | 0.5    | ٧     |
| I <sub>OZH</sub> | Off-State Output Current<br>High Level Voltage Applied | $V_{CC} = Max, V_{IH} = 2V, V_O = 2.4V, V_{IL} = 0.8V$   |     |     | 100    | μΑ    |
| I <sub>OZL</sub> | Off-State Output Current<br>Low Level Voltage Applied  | $V_{CC} = Max, V_{IH} = 2V, V_O = 0.4V, V_{IL} = 0.8V$   |     |     | - 100  | μΑ    |
| ų                | Input Current at<br>Maximum Input Voltage              | $V_{CC} = Max, V_I = 5.5V$                               |     |     | 1.0    | mA    |
| Чн               | High Level Input Current                               | $V_{CC} = Max, V_1 = 2.4V$                               |     |     | 25     | μA    |
| Ι <sub>ΙL</sub>  | Low Level Input Current                                | $V_{CC} = Max, V_I = 0.4V$                               |     |     | -250   | μΑ    |
| los              | Short Circuit Output Current                           | V <sub>CC</sub> = Max                                    | -30 |     | -130   | mA    |
| ICC              | Supply Current                                         | V <sub>CC</sub> = Max                                    |     | 150 | 225(1) | mA    |

T<sub>A</sub>, Operating Free Air Temperature

Min Typ

0

Max Units

°C

75

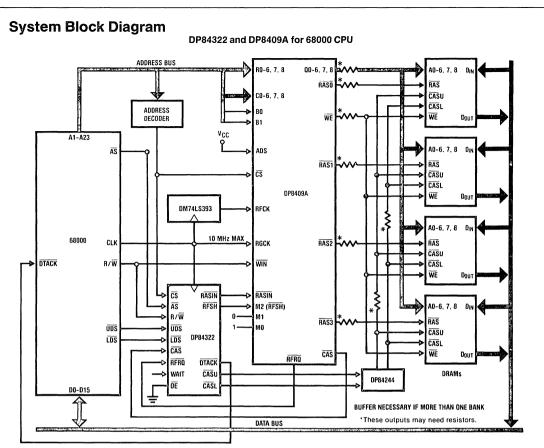
#### Switching Characteristics over recommended ranges of temperature and V<sub>CC</sub> (Note 3)

| Symbol           | Paramete                | r                        | Test Conditions<br>$R_L = 667\Omega$ | Т <sub>А</sub><br>V | Units |     |    |
|------------------|-------------------------|--------------------------|--------------------------------------|---------------------|-------|-----|----|
|                  |                         |                          |                                      | Min                 | Тур   | Max | 1  |
| t <sub>PD</sub>  | Input to Output         |                          | C <sub>L</sub> = 50 pF               |                     | 15    | 25  | ns |
| t <sub>PD</sub>  | Clock to Output         |                          |                                      |                     | 10    | 15  | ns |
| t <sub>PZX</sub> | Pin 11 to Output Enable |                          |                                      |                     | 10    | 20  | ns |
| t <sub>PXZ</sub> | Pin 11 to Output Di     | Pin 11 to Output Disable |                                      |                     | 11    | 20  | ns |
| t <sub>PZX</sub> | Input to Output Ena     | able                     | C <sub>L</sub> = 50 pF               |                     | 10    | 25  | ns |
| t <sub>PXZ</sub> | Input to Output Dis     | able                     | C <sub>L</sub> = 5 pF                |                     | 13    | 25  | ns |
| tw               | Width of Clock          | High                     |                                      | 15                  |       |     | ns |
|                  |                         | Low                      |                                      | 15                  |       |     | ns |
| t <sub>su</sub>  | Set-Up Time             |                          |                                      | 25                  |       |     | ns |
| t <sub>h</sub>   | Hold Time               |                          |                                      | 0                   | -10   |     | ns |

Note 1:  $I_{CC}$  = max at minimum temperature.

Note 2: One output at a time; otherwise 16 mA.

Note 3: If a PAL16R4B PAL is used, the Switching Characteristics will improve correspondingly.



TL/F/5003-3

DP84322

### **Mnemonic Description**

#### INPUT SIGNALS

- CLOCK The clock signal determines the timing of the outputs and should be connected directly to the 68000 clock input.
- AS Address Strobe from the 68000 CPU. This input is used to generate RASIN to the DP8409A.
- UDS, LDS Upper and lower data strobe from the 68000 CPU. These inputs, together with AS, R/W, provide DTACK to the 68000.
- CAS Column Address Strobe from the DP8409A. This input, together with LDS and UDS, provides two separate CAS outputs for accessing upper and lower memory data bytes.
- $\overrightarrow{CS} \qquad \begin{array}{l} Chip \; Select. \; This input \; enables \; \overline{DTACK} \; output. \\ \hline \overline{CS} \; = \; 0, \; \overline{DTACK} \; output \; is \; enabled; \; \overline{CS} \; = \; 1, \\ \hline \overline{DTACK} \; output \; is \; TRI-STATE^{\odot}. \end{array}$
- RFRQ Refresh Request. This input requests the DP84322 for a forced refresh.
- WAIT This input allows the necessary wait state to be inserted for memory access cycles.

#### OUTPUT SIGNALS

- RASINThis output provides a memory cycle start signal to the DP8409A and provides RAS timing during hidden refresh.
- DTACK This output is used to insert wait states into the 68000 memory cycles when selected and during a forced refresh cycle where the CPU attempts to access the memory. This output is enabled when CS input is low and at TRI-STATE when CS is high.
- RFSH This output controls the mode of the DP8409A. It always goes low for 4 CPU clock periods when AS is inactive and a forced refresh is requested through RFRQ input. This allows the DP8409A to perform an automatic forced refresh.

#### **Functional Description**

#### MEMORY ACCESS

As a 68000 bus cycle begins, a valid address is output on the address bus A1-A23. This address is decoded to provide Chip Select (CS) to the DP8409A. After the address becomes valid. AS goes low and it is used to set RASIN low from the DP84322 interface circuit. Note that CS must go low for a minimum of 10 ns before the assertion of RASIN for a proper memory access. As an example, with a 8 MHz 68000, the address is valid for at least 30 ns before  $\overline{AS}$  goes active. AS then has to ripple through the DP84322 to produce RASIN. This means the address is valid for a minimum of 40 ns before RASIN goes low, and the decoding of CS should take less than 30 ns. At this speed the DM74LS138 or DM74LS139 decoders can be selected to guarantee the 10 ns minimum required by CS set-up time going low before the access RASIN goes low (tose) of the DP8409A). This is important because a false hidden refresh may take place when the minimum t<sub>CSRL</sub> is not met. Typically RASIN occurs at the end of S2. Subsequently, selected RAS output, row to column select and then CAS will automatically follow RASIN as determined by mode 5 of the DP8409A. Mode 5 quarantees a 30 ns minimum for row address hold time (tRAH) and a minimum of 8 ns column address set-up time (tASC). If the system requires instructions that use byte writing, then CASU and CASL are needed for accessing upper and lower memory data bytes, and they are provided by the DP84322. In the DP84322, LDS and UDS are gated with CAS from the DP8409A to provide CASL and CASU, therefore designers need not be concerned about delaying CAS during write cycles to assure valid data being written into memory. The 8 MHz 68000 specifies during a write cycle that data output is valid for a minimum of 30 ns before DS goes active. Thus, CASL and CASU will not go low for at least 40 ns after the output data becomes stable, guaranteeing the 68000 valid data is written to memory.

Furthermore, the gating of UDS, LDS and CAS allows the DP84322 interface controller to support the test and set instruction (TAS). The 68000 utilizes the read-modify-write cycle to execute this instruction. The TAS instruction provides a method of communication between processors in a multiple processor system. Because of the nature of this instruction, in the 68000, this cycle is indivisible and the Address Strobe AS is asserted throughout the entire cycle, however DS is asserted twice for two accesses: a read then a write. The dynamic RAM controller and the DP84322 respond to this read-modity-write instruction as follows (refer to the TAS instruction timing diagram for clarification). First, the selected RAS goes low as a result of AS going low, and this RAS output will remain low throughout the entire cycle. Then the DP84322's selected CAS output (CASL or CASU) goes low to read the specified data byte. After this read, DS goes high causing the selected CAS to go high. A few clocks later R/W goes low and then DS is reasserted. As DS goes low, the selected CAS goes low strobing the CPU's modified data into memory, after which the cycle is ended when AS goes high.

The two CAS outputs from the DP84322, however, can only drive one memory bank. For additional driving capability, a memory driver such as the DP84244 should be added to drive loads of up to 500 pF.

Since this DP84322 interface circuit is designed to operate with all of the 68000 speed versions, a status input called WAIT is used to distinguish the 8 MHz from the others. The WAIT input should be set low for 6 MHz or less allowing full speed of operation with no wait states. Data Transfer Acknowledge input (DTACK) of the 68000 at these speeds is automatically inserted during S2 for every memory transaction cycle and is then negated at the end of that cycle when UDS and/or LDS go high. For the 8 MHz 68000 however, a wait state is required for every memory transaction cycle. At these speeds, the WAIT input is set high, selecting the DP8409A's CAS output to generate DTACK and again DTACK is negated at the end of the cycle when UDS or LDS goes high. Note that DTACK output is enabled only when the DP8409A's CS is low. Therefore when the 68000 is accessing I/O or ROM (in other words, when the DP8409A is not selected), the DP84322's DTACK output goes high impedance logic '1' through the external pull-up resistor and it is now up to the designer to supply DTACK for a proper bus cvcle.

The following table indicates the maximum memory speed in terms of the DRAM timing parameters: t<sub>CAC</sub> (access-time from CAS) and the (RAS precharge time) required by different 68000 speed versions:

| Microprocessor | Maximum          | Minimum         | Minimum |
|----------------|------------------|-----------------|---------|
| Clock          | t <sub>CAC</sub> | t <sub>RP</sub> | tRAS    |
| 8 MHz          | 125 ns           | 140 ns          | 220 ns  |
| 6 MHz          | 90 ns            | 170 ns          | 290 ns  |
| 4 MHz          | 270 ns           | 280 ns          | 450 ns  |

Pin 5 (R/W input to the DP84322) is not used as R/W when the WAIT input is high. Therefore, when WAIT is high and pin 5 is low, this is configured for the 8 MHz 68000. The dynamic RAM controller in this configuration operates in mode 5 and mode 1.

When both WAIT and pin 5 are high, this is configured for 4 MHz and 6 MHz 68000, allowing only two microprocessor clocks for memory refresh. Furthermore, the designer can use the DP8408A because the dynamic RAM controller now operates in mode 0 and mode 5 or mode 6. In addition, the programmable refresh timer, DP84300, should be used to determine the refresh rate (RFCK) and to provide the refresh request (RFRQ) input to the DP84322. The refresh timer can provide over two hundred different divisors. RFRQ is given at the beginning of every RFCK cycle and remains active until M2 goes low for memory refresh. The DP84322 samples RFRQ when AS is high, then sets M2 low for two microprocessor clocks, taking the DP8408A or DP8409A to the external control refresh mode. RASIN for this refresh is also issued by the DP84322. If a memory access is pending, RASIN for this access will not be given until it is delayed for approximately one microprocessor clock, allowing RAS precharge time for the dynamic RAMs.

The following table indicates different memory speeds in terms of the DRAM parameters required by 4 MHz and 6 MHz 68000:

#### Microprocessor Maximum Minimum Minimum Minimum

| Clock                                          | tCAC   | t <sub>RAS</sub> | t <sub>RP</sub> | tRAH  |  |  |  |
|------------------------------------------------|--------|------------------|-----------------|-------|--|--|--|
| 4 MHz                                          | 290 ns | 200 ns           | 225 ns          | 20 ns |  |  |  |
| 6 MHz                                          | 110 ns | 125 ns           | 140 ns          | 20 ns |  |  |  |
| DP8408A, DP8409A operate in mode 6 and mode 0. |        |                  |                 |       |  |  |  |

#### Functional Description (Continued)

When WAIT = 1, pin 5 = 0 (8 MHz), the PAL controller supports read and write cycles with one inserted wait state, forced refresh with five wait states inserted if  $\overline{CS}$  is valid, and hidden refresh. This PAL mode does not support the TAS instruction.

When WAIT = pin 5 = 1 (4–6 MHz), the PAL controller supports read and write cycles with no wait states inserted, and forced refresh with two wait states inserted if  $\overline{CS}$  is valid. This PAL mode does not support the TAS instruction and only supports hidden refresh when used in mode 5 with the DP8409A controller.

The DP84322 can possibly be operated at 8 MHz with no wait states (WAIT = "0") given the following conditions: FAST PAL (PAL16B4A)

S2 + S3 + S4 + S5 = 250 ns

 $\overline{\text{RASIN}}$  delay = 60 ns ( $\overline{\text{AS}}$  low max.)

+ 25 ns (Fast PAL delay) = 85 ns max.

 $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  delay DP8409-2 = 130 ns max.

External CASH, I generation using 74S02 and 74S240

7.5 ns (74S02) + 10 ns (74S240) - 7.5 ns (less load on 8409 CAS line) = 10 ns max.

Transceiver delay (74LS245) = 12 ns max.

68000 data setup into S6 = 40 ns min.

```
\therefore Minimum t<sub>CAC</sub> = 53 ns
```

= 250 - 85 - 130 - 10 - 12 + 40

 $\text{Minimum } t_{\text{RAS}} = 240 \text{ ns}$ 

Minimum t<sub>RP</sub> = 150 ns

Minimum t<sub>RAH</sub> = 20 ns

#### **REFRESH CYCLE**

Since the access sequence timing is automatically derived from  $\overline{\text{RASIN}}$  in mode 5, R/C and  $\overline{\text{CASIN}}$  are not used and now become Refresh Clock (RFCK) and  $\overline{\text{RAS}}$ -generator clock (RGCK) respectively. The Refresh Clock RFCK may be divided down from RGCK, which is the microprocessor clock, using the DM74LS393 or DM74LS390. RFCK provides the refresh time interval and RGCK the fast clock for all-RAS refresh if forced refreshing is necessary. The DP8409A offers both hidden refresh in mode 5 and forced refreshesh in mode 1 with priority placed on hidden refreshing. Assume 128 rows are to be refreshed, then a 16  $\mu$ s maximum clock period is needed for RFCK to distribute refreshing of all the rows over the 2 ms period.

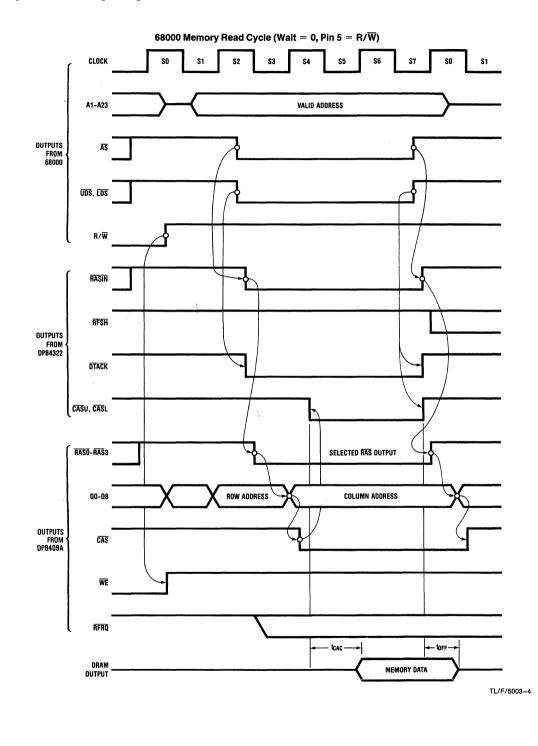
The DP8409A provides hidden refreshing in mode 5 when the refresh clock (RFCK) is high and the microprocessor is not accessing RAM. In other words, when the DP8409A's chip select is inactive because the microprocessor is accessing elsewhere, all four  $\overline{RAS}$  outputs follow  $\overline{RASIN}$ , strobing the contents of the on-chip refresh counter to every memory bank.  $\overline{RASIN}$  going high terminates the hidden refresh and also increments the refresh counter, preparing it for the next refresh cycle. Once a hidden refresh has taken place, a forced refresh will not be requested by the DP8409A for the current RFCK cycle.

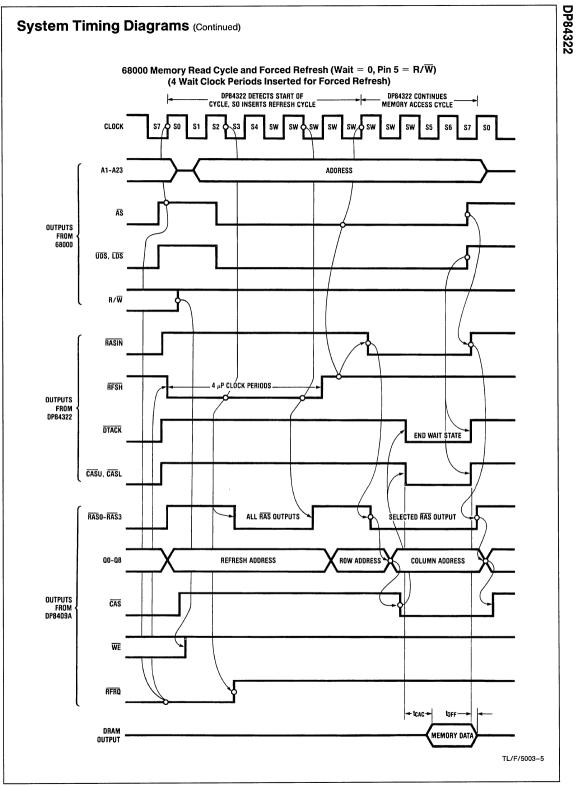
However, if the microprocessor continuously accessed the DP8409A and memory while RFCK was high, a hidden refresh could not have taken place and now the system must force a refresh. Immediately after RFCK goes low, the Refresh Request signal (RFRQ) from the DP8409A goes low, indicating a forced refresh is necessary. First, when RFRQ goes low any time during S2 to S7, the controller interface circuit waits until the end of the current memory access cycle and then sets M2 (RFSH) low. This refresh takes four microprocessor clocks to complete. If the current cycle is another memory cycle, the 68000 will automatically be put in four wait states. Alternately, when RFRQ goes low while AS is high during S0 to S1, M2 is now set low at S2. Therefore, it requires an additional microprocessor clock for this refresh. Once the DP8409A is in mode 1 forced refresh, all the RAS outputs remain high until two RGCK trailing edges after M2 goes low, when all RAS outputs go low. This allows a minimum of one and a half clock periods of RGCK for RAS precharge time. As specified in the DP8409A data sheet, the RAS outputs remain low for two clock periods of RGCK. The refresh counter is incremented as the RAS outputs go high. Once the forced refresh has ended, M2 is brought high, the DP8409A back to mode 5 auto access. Note that **RASIN** for the pending access is not given until it has been delayed for a full microprocessor clock, allowing RAS precharge time for the coming access.

If the 68000 bus is inactive (i.e., the 68000's instruction queue is full, or the 68000 is executing internal operations such as a multiply instruction, or the 68000 is in halt state ...) and a refresh has been requested, a refresh will also take place because  $\overline{\text{RFRQ}}$  is continuously sampled while  $\overline{\text{AS}}$  is high. Therefore, refreshing under these conditions will be transparent to the microprocessor. Consequently, the system throughput is increased because the DP84322 allows refreshing while the 68000 bus is inactive.

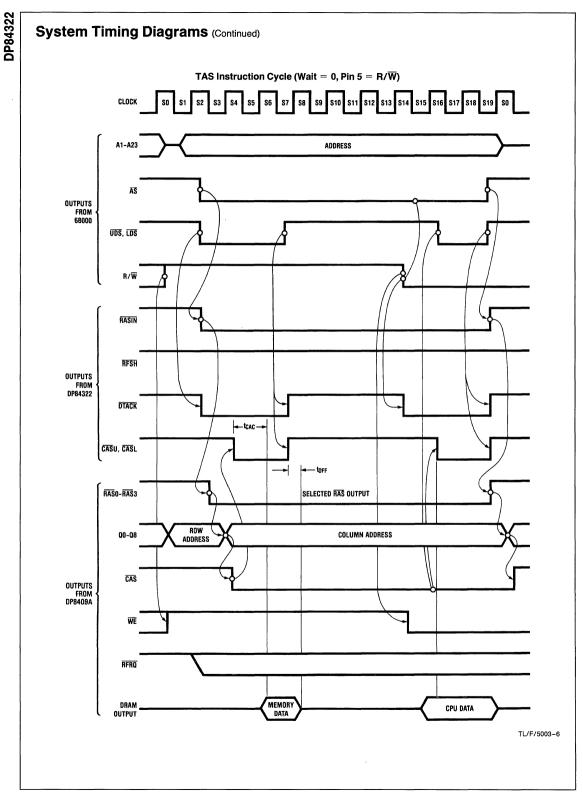
The 84322 is a standard National Semiconductor PAL part (DMPAL16R4). The user can modify the PAL equations to support his particular application. The 84322 logic equations function table (functional test), and logic diagram can be seen at the end of this data sheet.

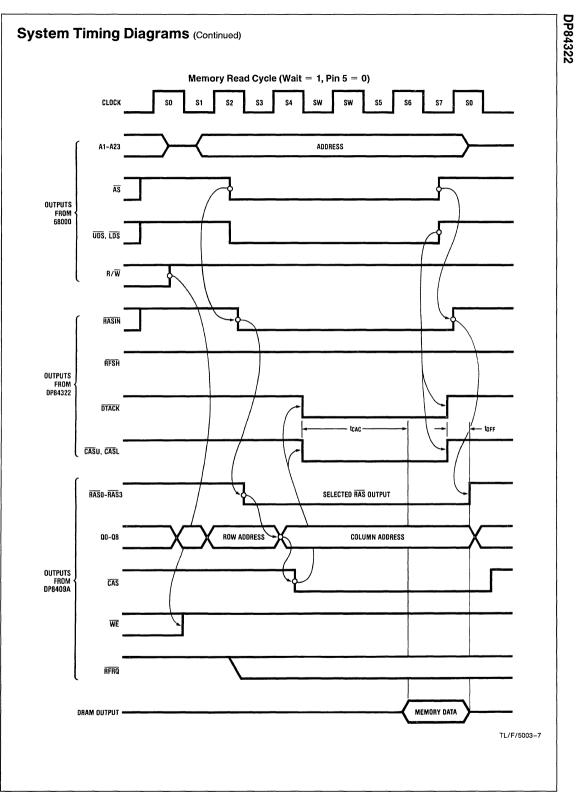
## System Timing Diagrams



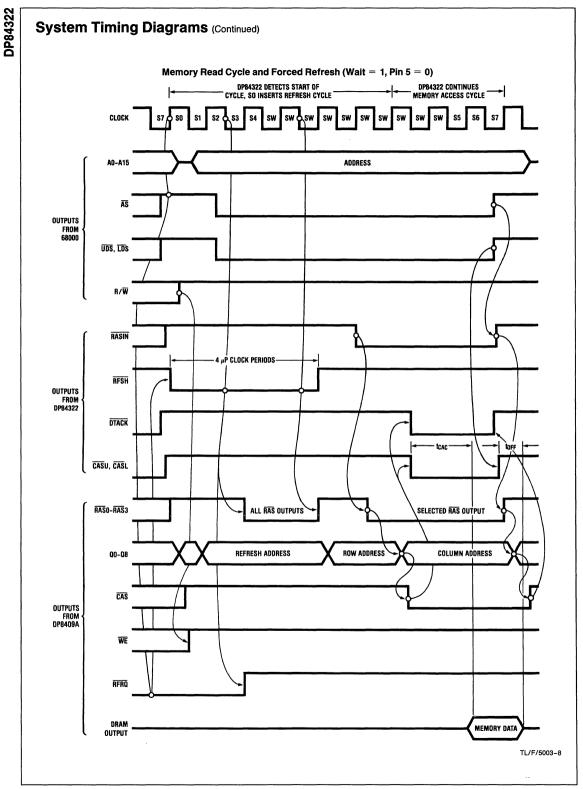


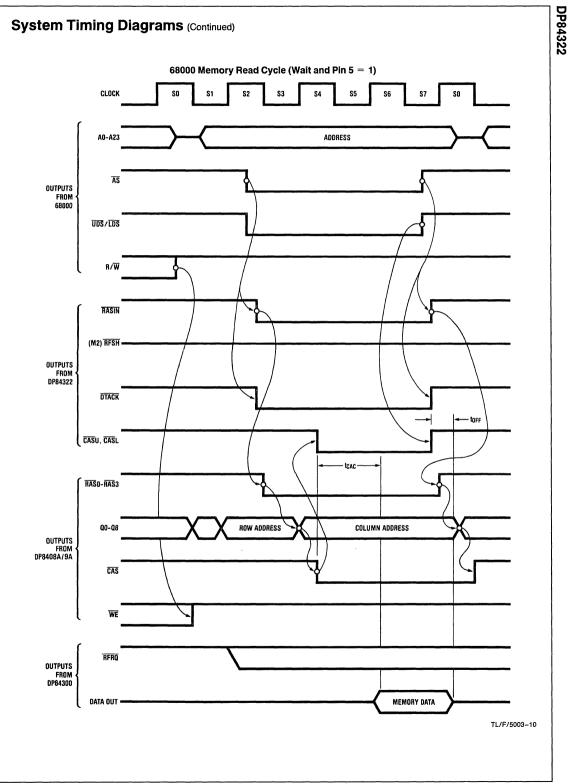
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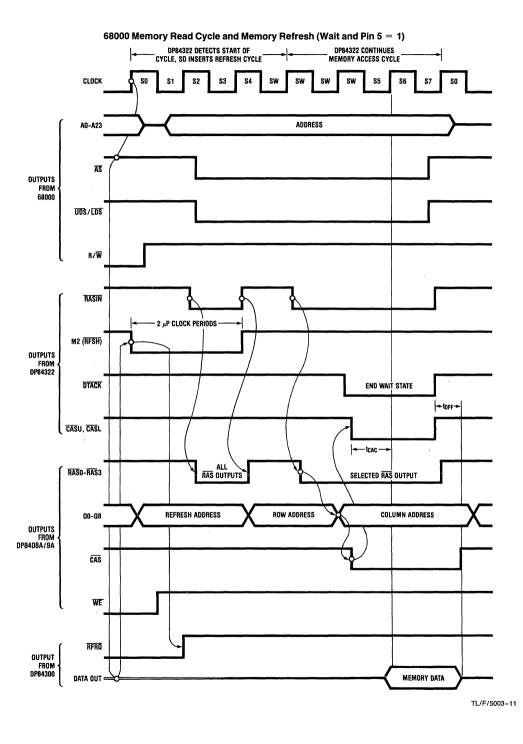


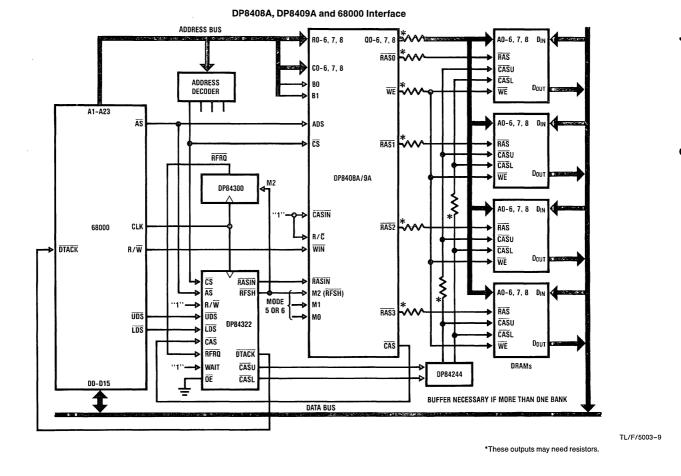
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## System Timing Diagrams (Continued)





3-21

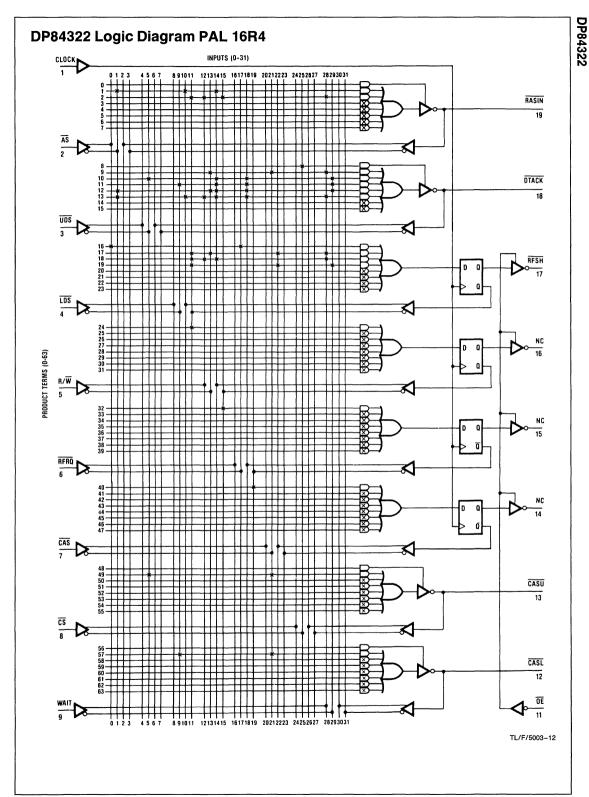
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### **PAL Boolean Equations**

PAL16R4 DP84322 Dynamic RAM Controller Interface for the MC68000-DP8409A Memory System CK /AS /UDS /LDS R /RFRQ /CAS /CS WAIT GND /OE /CL /CU /C /B /A /RFSH /DTACK /RASIN VCC IF (VCC) RASIN = AS • /RFSH • /A + RFSH • R • A • WAIT IF (CS) DTACK = /R • CAS • WAIT + UDS • /A • /B • /WAIT + LDS • /A • /B • /WAIT + AS • /R • /A • /B • /WAIT + AS • /RFSH • R • /A • /B • WAIT RFSH: = /AS • RFRQ + RFSH • /R • /C • WAIT + RFSH • R • /A • WAIT + RFSH • /C • /WAIT A: = RFSH B: = A C: = B IF (VCC) CU = UDS • CDS IF (VCC) CL = LDS • CAS

## **Function Table**

| CK | ĀS     | UDS | LDS | R            | RFRQ | CAS | <b>CS</b> | WAIT | ŌĒ | CL | CU  | Ē  | B  | Ā | RFSH | DTACK | RASIN |
|----|--------|-----|-----|--------------|------|-----|-----------|------|----|----|-----|----|----|---|------|-------|-------|
| С  | Н      | L   | L   | Н            | н    | н   | н         | L    | L  | н  | н   | Х  | Х  | Х | х    | х     | н     |
| С  | н      | L   | L   | н            | н    | L   | н         | L    | L  | L  | L   | х  | х  | х | х    | х     | н     |
| С  | н      | L   | н   | н            | н    | L   | н         | L    | L  | н  | L   | Х  | х  | х | Х    | Х     | н     |
| С  | Н      | н   | L   | н            | н    | L   | н         | L    | L  | L  | н   | Х  | х  | Х | Х    | Х     | н     |
| С  | н      | н   | н   | - <b>H</b> - | н    | н   | н         | L    | L  | н  | Н   | н  | н  | н | н    | Z     | н     |
| С  | L      | L   | н   | н            | н    | н   | L         | L    | L  | н  | н   | н  | Н  | н | н    | L     | L     |
| С  | L      | L   | н   | н            | н    | L   | L         | L    | L  | н  | L   | н  | н  | н | н    | L     | L     |
| С  | L      | н   | н   | н            | н    | L   | L         | L    | L  | н  | н   | н  | н  | н | н    | н     | L     |
| С  | L      | н   | H.  | Ľ            | н    | L   | L         | L    | L  | н  | н   | н  | н  | н | н    | L     | L     |
| С  | L      | L   | н   | L            | Н    | L   | L         | L    | L  | н  | L   | н  | н  | н | н    | L     | L     |
| С  | н      | н   | н   | L            | н    | н   | L         | L    | L  | н  | н   | н  | н  | н | н    | н     | н     |
| С  | н      | н   | н   | L            | L    | н   | L         | L    | L  | н  | н   | н  | н  | н | L    | н     | н     |
| С  | н      | н   | н   | L            | L    | н   | L         | L    | L  | н  | н   | н  | н  | L | L    | н     | н     |
| С  | L      | н   | L   | L            | н    | н   | L         | L    | L  | н  | н   | н  | L  | L | L    | н     | н     |
| С  | L      | н   | L   | L            | Н    | н   | L         | L    | L  | н  | н   | L  | L  | L | L    | н     | н     |
| С  | L      | н   | L   | L            | н    | н   | L         | L    | L  | н  | н   | L  | L  | L | н    | н     | н     |
| С  | L      | н   | L   | L            | н    | н   | L         | L    | L  | н  | Н   | L  | L  | н | н    | н     | L     |
| С  | L      | н   | L   | L            | н    | L   | L         | L    | L  | L  | Н   | L  | н  | н | н    | L     | L     |
| С  | L      | н   | L   | L            | н    | L   | L         | L    | L  | L  | н   | н  | н  | н | н    | L     | L     |
| С  | н      | н   | н   | L            | н    | L   | L         | L    | L  | н  | н   | н  | н  | н | н    | н     | н     |
| С  | н      | н   | н   | L            | L    | н   | L         | н    | L  | н  | н   | н  | н  | н | L    | н     | н     |
| С  | н      | н   | н   | L            | L    | н   | L         | н    | L  | Н  | . Н | H. | н  | L | L    | н     | н     |
| С  | L      | L   | L   | L            | н    | н   | L         | н    | L  | н  | н   | н  | L  | L | L    | ́ Н   | н     |
| С  | L      | Ł   | L   | L            | Н    | н   | L         | н    | L  | н  | н   | ۲· | L  | L | L    | н     | н     |
| С  | L      | L   | L   | L            | н    | н   | L         | н    | L  | н  | н   | L  | L  | L | н    | н     | н     |
| С  | L      | L   | L   | L            | н    | н   | L         | н    | L  | н  | н   | L  | L  | н | Н    | H     | L     |
| С  | L      | L   | L   | L            | н    | L   | L         | н    | L  | L  | L   | L  | н  | н | н    | L     | L     |
| С  | н      | н   | н   | L            | н    | L   | L         | н    | L  | н  | н   | н  | н  | н | н    | L     | н     |
| С  | н      | н   | н   | L            | н    | н   | н         | н    | L  | Н  | н   | н  | н  | н | н    | Z     | н     |
| С  | н      | н   | н   | н            | L    | н   | L         | н    | L  | н  | н   | н  | H, | н | L    | н     | н     |
| С  | н      | н   | н   | н            | L    | н   | L         | н    | L  | Н  | н   | н  | н  | L | L    | н     | L     |
| С  | L      | L   | н   | н            | н    | н   | L         | н    | L  | н  | н   | н  | L  | L | н    | н     | н     |
| С  | L      | L   | н   | Н            | Н    | Н   | L         | н    | L  | Н  | н   | L  | L  | н | н    | Н     | L     |
| С  | L      | L   | н   | н            | н    | L   | L         | н    | L  | Н  | L   | L  | н  | н | н    | L ·   | L     |
| С  | H<br>H | Н   | н   | Н            | Н    | L   | L         | н    | L  | Н  | н   | н  | н  | н | н    | н     | Н     |
| č  |        | н   | н   | н            | н    | н   | L         | н    | н  | н  | н   | Z  | Z  | Z | Z    | н     | н     |



## National Semiconductor

# DP84412 Dynamic RAM Controller Interface Series Circuit for the Series 32000<sup>®</sup> CPU

## **General Description**

**Connection Diagram** 

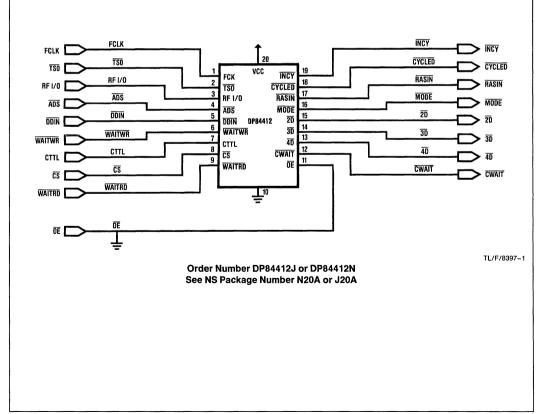
The DP84412 is a new Programmable Array Logic (PAL®) device, that replaces the DP84312, designed to allow an easy interface between the National Semiconductor Series 32000 family of processors and the National Semiconductor DP8409A, DP8429, or DP8419 DRAM controller.

The new DP84412 supplies all the control signals needed to perform memory read, write and refresh and work with the National Semiconductor Series 32000 family of processors up to 10 MHz. Logic is also included to insert WAIT states, if wanted, into the microprocessor READ or WRITE cycles when using fast CPUs.

#### Features

Provides a 3-chip solution for the Series 32000 family, dynamic RAM interface (DP8409A or DP8419, DP84412, and clock divider).

- Works with all Series 32000 family speed versions up to 10 MHz.
- Operation of Series 32000 processor at 10 MHz with no WAIT states.
- Controls DP8409A or DP8419 Mode 5 accesses, hidden refreshes and Mode 1 Forced Refreshes automatically.
- Inserts WAIT states in READ or WRITE cycles automatically depending on whether WAITRD or WAITWR are low, or if CS becomes active during a forced Refresh cycle.
- Uses a standard National Semiconductor PAL part (DMPAL16R6A).
- The PAL logic equations can be modified by the user for his specific application and programmed into any of the PALs in the National Semiconductor family, including the new very high speed PALs ("B" PAL parts).



#### **Absolute Maximum Ratings**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

|                                 | Operating | Programming |    |
|---------------------------------|-----------|-------------|----|
| Supply Voltage, V <sub>CC</sub> | 7V        | 12V         | (  |
| Input Voltage                   | 5.5V      | 12V         | \$ |

Off-State Output Voltage Storage Temperature Range

## **Recommended Operating Conditions**

| Cumbal          | Parameter                                     |     |      | Units |      |       |  |
|-----------------|-----------------------------------------------|-----|------|-------|------|-------|--|
| Symbol          | Parameter                                     |     | Min  | Тур   | Max  | Units |  |
| V <sub>CC</sub> | Supply Voltage                                |     | 4.75 | 5     | 5.25 | V     |  |
| +               | Width of Clock                                | Low | 15   | 10    |      |       |  |
| t <sub>w</sub>  |                                               | 15  | 10   |       | ns   |       |  |
| t <sub>su</sub> | Setup Time from Input<br>or Feedback to Clock |     | 25   | 16    |      | ns    |  |
| t <sub>h</sub>  | Hold Time                                     |     | 0    | -10   |      | ns    |  |
| T <sub>A</sub>  | Operating Free-Air Temperature                |     | 0    | 25    | 75   | °C    |  |
| T <sub>C</sub>  | Operating Case Temperature                    |     |      |       |      | °C    |  |

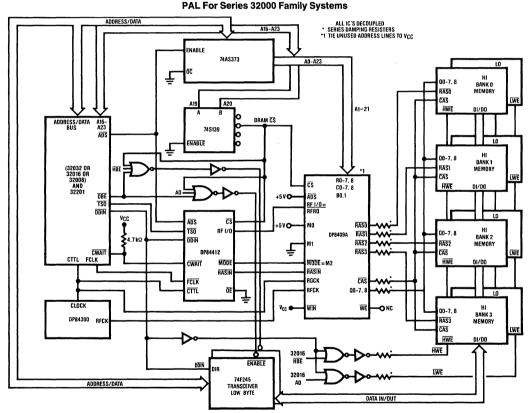
#### Electrical Characteristics Over Recommended Operating Temperature Range

| Symbol           | Parameter                    | Τe                                                                          | est Conditions                 | Min | Тур   | Max   | Units |
|------------------|------------------------------|-----------------------------------------------------------------------------|--------------------------------|-----|-------|-------|-------|
| VIH              | High Level Input Voltage     |                                                                             |                                | 2   |       |       | v     |
| VIL              | Low Level Input Voltage      |                                                                             |                                |     |       | 0.8   | v     |
| VIC              | Input Clamp Voltage          | V <sub>CC</sub> = Min, I <sub>I</sub>                                       | = -18 mA                       |     | -0.8  | -1.5  | v     |
| V <sub>OH</sub>  | High Level Output Voltage    | $\begin{array}{l} V_{CC} = Min \\ V_{IL} = 0.8V \\ V_{IH} = 2V \end{array}$ | $I_{OH} = -3.2 \text{ mA}$ COM | 2.4 | 2.8   |       | v     |
| V <sub>OL</sub>  | Low Level Output Voltage     | $\begin{array}{l} V_{CC} = Min \\ V_{IL} = 0.8V \\ V_{IH} = 2V \end{array}$ | $I_{OL} = 24 \text{ mA COM}$   |     | 0.3   | 0.5   | v     |
| lozh             |                              | V <sub>CC</sub> = Max                                                       | $V_0 = 2.4V$                   |     |       | 100   | μΑ    |
| I <sub>OZL</sub> | Off-State Output Current     | V <sub>IL</sub> = 0.8V<br>V <sub>IH</sub> = 2V                              | $V_{O} = 0.4V$                 |     |       | -100  | μΑ    |
| l <sub>l</sub>   | Maximum Input Current        | V <sub>CC</sub> = Max, V                                                    | / <sub>I</sub> = 5.5V          |     |       | 1     | mA    |
| ſн               | High Level Input Current     | V <sub>CC</sub> = Max, V                                                    | $l_{\rm l} = 2.4 V$            |     |       | 25    | μA    |
| I <sub>IL</sub>  | Low Level Input Current      | V <sub>CC</sub> = Max, V                                                    | $V_{1} = 0.4 V$                |     | -0.02 | -0.25 | mA    |
| los              | Output Short-Circuit Current | $V_{CC} = 5V$                                                               | $V_{O} = 0V$                   | -30 | -70   | - 130 | mA    |
| Icc              | Supply Current               | V <sub>CC</sub> = Max                                                       |                                |     | 120   | 180   | mA    |

Switching Characteristics Over Recommended Ranges of Temperature and V<sub>CC</sub>  $V_{CC} = 5V \pm 10\%$ . Commercial: T<sub>A</sub> = 0°C to 75°C, V<sub>CC</sub> = 5V ±5%

| Symbol           | Parameter                   | Test Conditions |     | Units   |    |       |
|------------------|-----------------------------|-----------------|-----|---------|----|-------|
| oyinbor          | rarameter                   | R1, R2          | Min | Тур Мах |    | Onits |
| t <sub>PD</sub>  | Input or Feedback to Output |                 |     | 15      | 25 | ns    |
| t <sub>CLK</sub> | Clock to Output or Feedback | CL = 50 pF      |     | 10      | 15 | ns    |
| t <sub>PZX</sub> | Pin 11 to Output Enable     |                 |     | 10      | 20 | ns    |
| t <sub>PXZ</sub> | Pin 11 to Output Disable    | $C_L = 5  pF$   |     | 11      | 20 | ns    |
| t <sub>PZX</sub> | Input to Output Enable      | $C_L = 50  pF$  |     | 10      | 25 | ns    |
| t <sub>PXZ</sub> | Input to Output Disable     | $C_L = 5  pF$   |     | 13      | 25 | ns    |
| fMAX             | Maximum Frequency           |                 | 25  | 30      |    | ns    |

V<sub>CC</sub> = Max at minimum temperature.



TL/F/8397-2

#### **Mnemonic Description**

| 14111    | emonic De         | scription                                                                                                                                                                                                                                                                               |
|----------|-------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| INPU     | TS SIGNALS        |                                                                                                                                                                                                                                                                                         |
| 1)       | "FCLK"            | Fast clock from the NS32201 TCU                                                                                                                                                                                                                                                         |
| 1)       | FOLK              | clock chip, this signal runs at twice<br>the speed of the system clock.                                                                                                                                                                                                                 |
| 2)       | " <u>TSO</u> "    | From the NS32201 TCU clock chip, this signal indicates the start of the                                                                                                                                                                                                                 |
| 0)       | "DEL (Q)          | "T2" state and goes high at the be-<br>ginning of the "T4" state.                                                                                                                                                                                                                       |
| 3)<br>4) | "RFI/O"<br>"ADS"  | RFRQ (refresh request) in mode 5.<br>From 8409A, an active low signal.                                                                                                                                                                                                                  |
| 4)       | ADS               | From the Series 32000 CPU, address<br>strobe. If the system includes the<br>MMU (NS32082) then PAV should be<br>connected to this input.                                                                                                                                                |
| 5)       | "DDIN"            | Used to differentiate between READ and WRITE cycles, and to allow $\overline{CS}$ READ cycles to start early.                                                                                                                                                                           |
| 6)       | "WAITWRITE"       | This signal is used to add a WAIT<br>state into a CS WRITE access cycle,<br>and delay RASIN until the end of the<br>"T2" clock period.                                                                                                                                                  |
| 7)       | "CTTL"            | From the NS32201 TCU clock chip, this signal runs at the system clock frequency.                                                                                                                                                                                                        |
| 8)       | " <del>CS</del> " | From decoder chip (chip select) (ac-<br>tive low).                                                                                                                                                                                                                                      |
| 9)       | "WAITREAD"        | Used to insert 1 wait state into the Series 32000 READ bus cycle. The wait state allows the use of memory with longer access times ( $t_{CAC}$ ). An active low signal.                                                                                                                 |
| 10)      | " <del>OE</del> " | This input enables the outputs of the "D-Flip Flop" outputs of the PAL.                                                                                                                                                                                                                 |
| OUT      | PUTS SIGNALS      |                                                                                                                                                                                                                                                                                         |
| 1)       | "MODE"            | This pin goes to M2 on the DP8409A to change from mode 5 to mode 1 (only used for forced refresh).                                                                                                                                                                                      |
| 2)       | "2DLY"            | Delay used internal to the PAL.                                                                                                                                                                                                                                                         |
| 3)       | "3DLY"            | Delay used internal to the PAL.                                                                                                                                                                                                                                                         |
| 4)       | "4DLY"            | Delay used internal to the PAL.                                                                                                                                                                                                                                                         |
| 5)       | "RASIN"           | To the 8409A (creates RASs). Goes<br>low earlier for READ cycles than<br>WRITE cycles.                                                                                                                                                                                                  |
| 6)       | "CYCLED"          | Goes active low once a hidden re-<br>fresh (non CS cycle) or DRAM access<br>has been performed. CYCLED always<br>goes low at the beginning of the "T3"<br>processor state. This signal goes high<br>(reset) by the end of the processor<br>bus cycle as indicated by TSO being<br>high. |
| 7)       | "CWAIT"           | This output inserts "WAIT" or "HOLD" states into the NS32016 machine cycles (only WAIT states are used in this application). This output is in "not enabled" condition when $\overline{CS}$ is high (not chip selected).                                                                |
| 8)       | "INCYCLE"         | This signal goes active from the CPU<br>ADS signal. This signal indicates that<br>the processor is doing an access<br>somewhere in the system. This signal<br>stays low for several T states of the<br>access cycle.                                                                    |

### **Functional Description**

The following description applies to both the DP8409A and the DP8419 dynamic RAM controllers.

A memory cycle starts when chip select ( $\overline{CS}$ ) and address strobe ( $\overline{ADS}$ ) are true. RASIN is supplied from the DP84412 to the DP8409A dynamic RAM controller, which then supplies a RAS signal to the selected dynamic RAM bank. After the necessary row address hold time, the DP8409A switches the address outputs to the column address. The DP8409A then supplies the required CAS signal to the DRAM. In order to do byte operations it is suggested that the user provide external logic, as shown in the system block diagram, to produce a HIGH WRITE ENABLE and/or a LOW WRITE ENABLE. To differentiate between a READ and a WRITE, the  $\overline{DDIN}$  signal from the CPU is used.  $\overline{DDIN}$ is also supplied to the external WRITE ENABLE logic.

A refresh cycle is started by one of two conditions. The refresh cycle caused by the first condition is called a hidden refresh. This occurs when refresh clock (RFCK) is high. CS is not true, and RASIN goes true. Here the CPU is accessing something else in the system and the DRAM can be refreshed at that time, thereby being transparent to the CPU. The second type of refresh is called forced refresh. This occurs if no hidden refresh was performed while RFCK was high. When RFCK transitions low a refresh request (RFRQ) is generated. If there is not a DRAM access in progress the DP84412 will force a refresh by putting the DP8409A into mode 1 (automatic forced refresh mode). If the CPU tries to access the DRAM during a forced refresh cycle WAIT states will be inserted into its cycles until the forced refresh is over and the DRAM RAS precharge time has been met. Then the pending DRAM access will be allowed to take place.

The DP84412 also allows forced refreshes to take place during long accesses of other devices. For instance, if EEPROM takes several microseconds to write to, the DRAM will still be refreshed while that access is in progress.

In a standard memory cycle, the access can be slowed down by one clock cycle to accommodate slower memories or allow time to generate parity. This is accomplished by inserting a WAIT state into the processor access cycle. The DP84412 can insert WAIT states into either READ or WRITE cycles, or both. The extra WAIT state will not appear during the hidden refresh cycle, so faster devices on the CPU bus will not be affected.

### **System Interface Description**

All members of the Series 32000 family of processors are able to use the DP84412.

The DP84412 differentiates between READ and WRITE cycles, allowing the RASIN signal to start earlier during a READ cycle compared to a WRITE cycle.

RASIN during a READ cycle will always start at the beginning of the "T2" processor cycle. The user must also guarantee that  $\overline{CS}$  is valid a minimum of 30 ns before RASIN becomes valid. The worst case would be at 10 MHz where FCLK preceeds PHI1 by a maximum of 10 ns. RASIN can occur a minimum of approximately 8 ns after FCLK. Therefore  $\overline{CS}$  must occur a minimum of 32 ns (30 ns+2 ns) before the rising edge of PHI1 at 10 MHz.

The user may want to tie  $\overline{\text{CS}}$  low on the DP8409A/19 (disable HIDDEN REFRESH) and use the system transceivers to select the DRAM. In this case one only needs to concern himself with the 10 ns address setup time to  $\overline{\text{RASIN}}$ .

#### System Interface Description (Continued)

The DP84412 can be used in a system with the MMU (NS32082) but the signal  $\overrightarrow{PAV}$  would be connected to the  $\overrightarrow{ADS}$  input instead of  $\overrightarrow{ADS}$ .

Several other critical parameters in this application that involve the input signals DDIN, CWAIT, TSO, and FCLK. These parameters become most critical at 10 MHz where it is suggested that they are directly connected to the corresponding pins of the Series 32000 family ICs.

This section of the data sheet goes through the calculation of the "tRAC" (RAS access time) and "tCAC" (CAS access time) required by the DRAM for the Series 32000 family CPUs to operate at a particular clock frequency without introducing wait states into the processor access cycles. Both "tRAC" and "tCAC" must be considered in determining what speed DRAM can be used in a particular system design. The DRAM chosen must meet both the "tRAC" and "tCAC" parameters calculated. In order to determine the "tRAC" and "tCAC" needed the DP8419 and fast PALs ("B" type PALs) timing parameters were used. If the user is using the DP8408A/09A or a slower PAL device he should substitute their respective delays into the equations below.

Most all of the calculations contained in this note use "RAHS" = 1 (15 ns guaranteed minimum row address hold time). Calculations only used "RAHS" = 0 (25 ns guaranteed minimum row address hold time) when the calculated access time from RAS exceeded 200 ns. This is because DRAMs can be found with row access times up to 150 ns that require only 15 ns row address hold times.

#### **EXAMPLE DRAM TIMING CALCULATIONS**

#### A) 8 MHz Series 32000 CPU, No Wait states

- #1) <u>RASIN</u> = T1 2 ns (FCLK to PHI1 skew) + 12 ns ("B" PAL clocked output) = 125 - 2 + 12 = 135 ns maximum
- #2)  $\overline{\text{RASIN}}$  to  $\overline{\text{RAS}}$  low = 20 ns maximum (DP8419)
- #3) RASIN to CAS low = 80 ns (DP8419 RASIN CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns
- #4) 74F245 transceiver delay = 7 ns maximum
- #5) CPU data setup time to "T4" = data setup to PHI2 T.E. + maximum PHI2 F.E. to PHI1 R.E. = 15 + 5 = 20 ns minimum

"tRAC" = T1 + T2 + T3 - #1 - #2 - #4 - #5

= 125 + 125 + 125 - 135 - 20 - 7 - 20 = 193 ns

"tCAC" = T1 + T2 + T3 - #1 - #3 - #4 - #5

Therefore the DRAM chosen should have a "tRAC" less then or equal to 193 ns and a "tCAC" less than or equal to 136 ns. Standard 150 ns DRAMs meet this criteria.

The minimum  $\overline{\text{RAS}}$  PRECHARGE TIME will be approximately one and one half clock periods = 125+62=187 ns. The minimum  $\overline{\text{CAS}}$  PRECHARGE TIME will be approximately one and one half clock periods plus 35 ns (minimum  $t_{\text{RICL}} - t_{\text{RICH}}$  for the DP8409-2) = 125+62+35=222 ns.

The minimum  $\overline{\text{RAS}}$  PULSE WIDTH will be approximately two clock periods -5 ns (maximum  $t_{\text{RPDL}} - t_{\text{RPDH}}$  for the DP8409-2) = 250 -5 = 245 ns.

The minimum  $\overline{\text{CAS}}$  PULSE WIDTH will be approximately two clock periods -70 ns (maximum  $t_{\text{RICL}}-t_{\text{RICH}}$  for the DP8409-2) = 250 -70 = 180 ns.

The smallest pulse widths are generated during WRITE cycles since RASIN during WRITE cycles starts later than RASIN during READ cycles.

If one inserted a WAIT state in READ cycles the DRAM column access times and the  $\overline{\text{RAS}}$  pulse width would be increased by one clock period (125 ns in this case). A WAIT state in WRITE cycles would just increase the  $\overline{\text{RAS}}$  pulse width by one clock period.

#### B) 10 MHz Series 32000, No Wait States

- #1) <u>RASIN</u> low = T1 2 ns (FCLK PHI1 skew) + 12 ns ("B" PAL clocked output) = 100 - 2 + 12 = 110 ns maximum
- #2)  $\overline{RASIN}$  to  $\overline{RAS}$  low = 20 ns maximum
- #3)  $\overrightarrow{RASIN}$  to  $\overrightarrow{CAS}$  low = 80 ns maximum (DP8419  $\overrightarrow{RASIN}$ - $\overrightarrow{CAS}$  low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns
- #4) 74F245 transceiver delay = 7 ns maximum
- #5) CPU data setup time to "T4" = data setup to PHI2 T.E. + maximum PHI2 F.E. to PHI1 R.E. = 15 + 5 = 15 ns minimum

"tRAC" = T1 + T2 + T3 - #1 - #2 - #4 - #5

=100+100+100-110-20-7-15=148 ns

"tCAC" = T1 + T2 + T3 - #1 - #3 - #4 - #5

Therefore the DRAM chosen should have a "tRAC" less then or equal to 148 ns and a "tCAC" less than or equal to 91 ns. Standard 120 ns DRAMs meet this criteria.

The minimum RAS PRECHARGE TIME will be approximately one and one half clock periods = 100 + 50 = 150 ns. The minimum CAS PRECHARGE TIME will be approximately one and one half clock periods plus 35 ns (minimum t<sub>RICL</sub>-t<sub>RICH</sub> for the DP8409-2) = 100 + 50 + 35 = 185 ns.

The minimum  $\overline{\text{RAS}}$  PULSE WIDTH will be approximately two clock periods -5 ns (maximum  $t_{\text{RPDL}} - t_{\text{RPDH}}$  for the DP8409-2) = 200 -5 = 195 ns.

The minimum  $\overline{\text{CAS}}$  PULSE WIDTH will be approximately two clock periods - 70 ns (maximum  $t_{\text{RICL}}-t_{\text{RICH}}$  for the DP8409-2) = 200 - 70 = 130 ns.

The smallest pulse widths are generated during WRITE cycles since RASIN during WRITE cycles starts later than RASIN during READ cycles.

If one inserted a WAIT state in READ cycles the DRAM column access times and the  $\overline{\text{RAS}}$  pulse width would be increased by one clock period (100 ns in this case). A WAIT state in WRITE cycles would just increase the  $\overline{\text{RAS}}$  pulse width by one clock period.

#### SUGGESTIONS

It is suggested that the DP8409A could be used up to 8 MHz. Above 8 MHz one should use the DP8409-2 or the DP8419. Also, fast PALs ("A" or "B" parts) should be used at 8 MHz and above.

#### **INTERPRETING THE DP84412 PAL EQUATIONS**

The boolean equations for the DP84412 were written using the standard PALASM™ format. In other words the equation: "IF (V<sub>CC</sub>) RASIN=INCY\*MODE\*4D\*DDIN" will mean;

The output "RASIN" (see pin list for DP84412) will be active low (inverted RASIN) when the output "INCY" is low (making INCY high) AND the output "MODE" is high AND the output " $\overline{4D}$ " is low (making 4D high) AND the input  $\overline{DDIN}$  is low (making DDIN high).

#### **PAL Boolean Equations**

PAL16R6A;FAST PALNEW PAL FOR THE NATIONAL SEMICONDUCTOR NS32016, 32008, 32032NATIONAL SEMICONDUCTOR (WORKS UP 10 MHz)

 $\frac{\text{FCLK} \ \overline{\text{TSO}} \ }{\text{OE} \ \overline{\text{CWAIT}} \ \overline{\text{HDI}} \ \overline{\text{ADS}} \ \overline{\text{DDIN}} \ \overline{\text{WAITWR}} \ \overline{\text{CTTL}} \ \overline{\text{CS}} \ \overline{\text{WAITRD}} \ \overline{\text{GND}} \\ \overline{\text{OE} \ \overline{\text{CWAIT}}} \ \overline{\text{ADLY}} \ \overline{\text{3DLY}} \ \overline{\text{2DLY}} \ \overline{\text{MODE}} \ \overline{\text{RASIN}} \ \overline{\text{CYCLED}} \ \overline{\text{INCY}} \ VCC$ 

| RASIN | := | INCY*CYCLED*MODE*CTTL*DDIN+    | Start RASIN fast during               |
|-------|----|--------------------------------|---------------------------------------|
|       |    |                                | ; "READ" cycle                        |
|       |    | INCY*MODE*2DLY*WAITWR+         | ; ''WRITE'' cycle_without WAIT states |
|       |    | CS•INCY•MODE•2DLY+             | ; Hidden Refresh RASIN                |
|       |    | CS•INCY•MODE•2DLY•WAITWR•CTTL+ | ; ''WRITE'' cycle with WAIT states    |
|       |    | RASIN•INCY•MODE•2DLY           | ; continue RASIN                      |

 CYCLED := MODE\*2DLY\*WAITWR\*DDIN\*CTTL + MODE\*2DLY\*WAITRD\*DDIN\*CTTL + MODE\*2DLY\*AITRD\*DDIN\*CTTL + MODE\*2DLY\*4DLY\*WAITRD\*DDIN\*CTTL + MODE\*2DLY\*4DLY\*WAITWR\*DDIN\*CTTL + KOWAITS inserted WAITS inserted WAIT in READ cycle

 WAITS inserted WAITS inserted WAIT in READ cycle

 WAITS inserted WAITS inserted WAIT in WRITE cycle

 WAITS inserted WAITS inserted WAIT in WRITE cycle

 WAITS inserted WAITS inserted WAIT in WRITE cycle

 MODE := RFI0\*INCY\*2DLY\*CTTL+
 ;forced refresh during idle

 MODE\*3DLY+
 ;states, in long cycles,

 MODE\*4DLY+
 ;or at the end of a cycle

2DLY := MODE\*4DLY\*CTTL+ 2DLY\*CTTL+ INCY\*CYCLED\*MODE\*3DLY\*4DLY\*CTTL+ CS\*DDIN\*WAITRD\*INCY\*MODE\*2DLY\*3DLY\*4DLY+ CS\*DDIN\*WAITWR\*INCY\*MODE\*2DLY\*3DLY\*4DLY ; WAIT states are wanted

3DLY := 2DLY\*4DLY\*CTTL+ 3DLY\*CTTL

MODE\*CTTL

4DLY := 3DLY\*CTTL+ 4DLY\*CTTL+ INCY\*MODE\*CTTL+ INCY\*MODE\*2DLY\*CTTL

IF (VCC) INCY = ADS\*<u>MODE</u>+ CS\*TSO\*<u>CYCLED</u>\*<u>MODE</u>\*<u>2DLY</u>\*4DLY+ INCY\*<u>CYCLED</u>+ INCY\*<u>CYCLED</u>+ INCY\*2DLY ;refresh

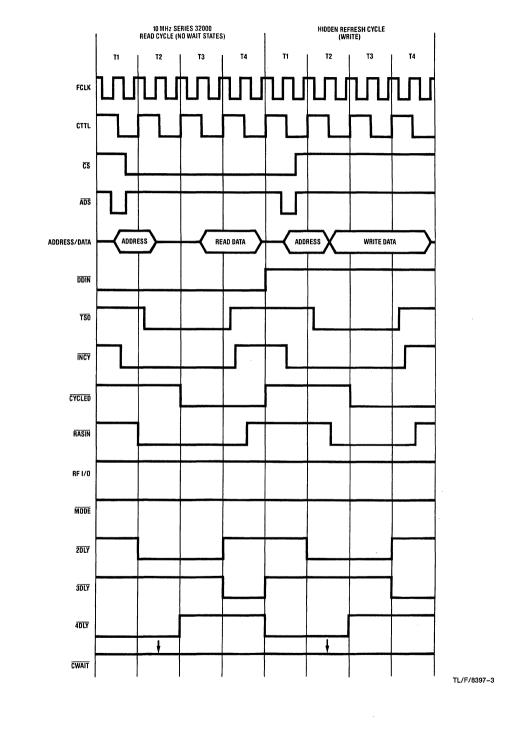
IF (CS) CWAIT=CS\*TSO\*CYCLED\*MODE\*2DLY\*4DLY+ ;for Access during ;forced refresh CS\*TSO\*MODE+ ;during forced refresh CS\*INCY\*CYCLED\*DDIN\*WAITRD\*MODE\*2DLY\*3DLY\*4DLY+ ; CS READ cycle with ;WAIT states CS\*INCY\*CYCLED\*DDIN\*WAITWR\*MODE\*2DLY\*3DLY\*4DLY

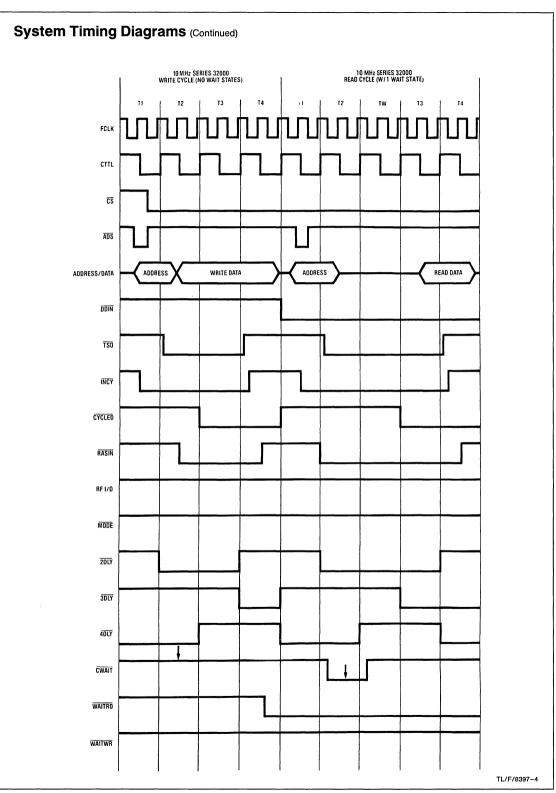
;  $\overline{\text{CS}}$  WRITE cycle with

; WAIT states

FIGURE 1. Equations for the Series 32000 Family Interface PAL

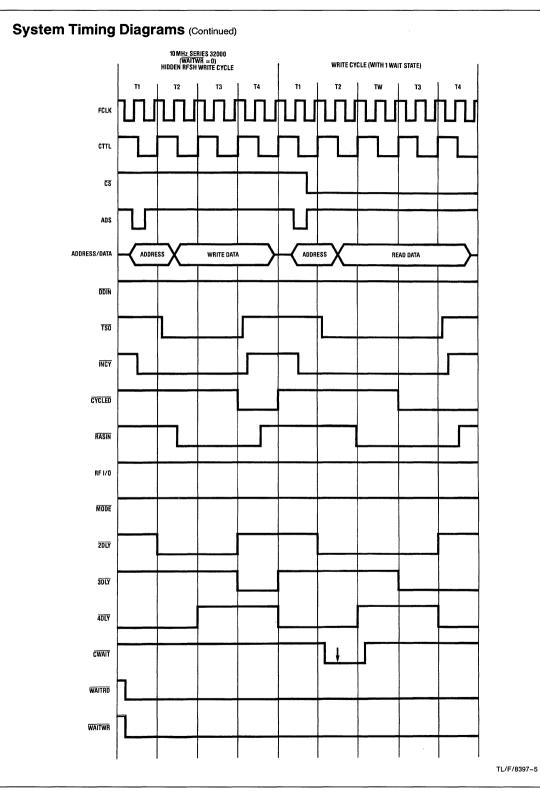
## System Timing Diagrams

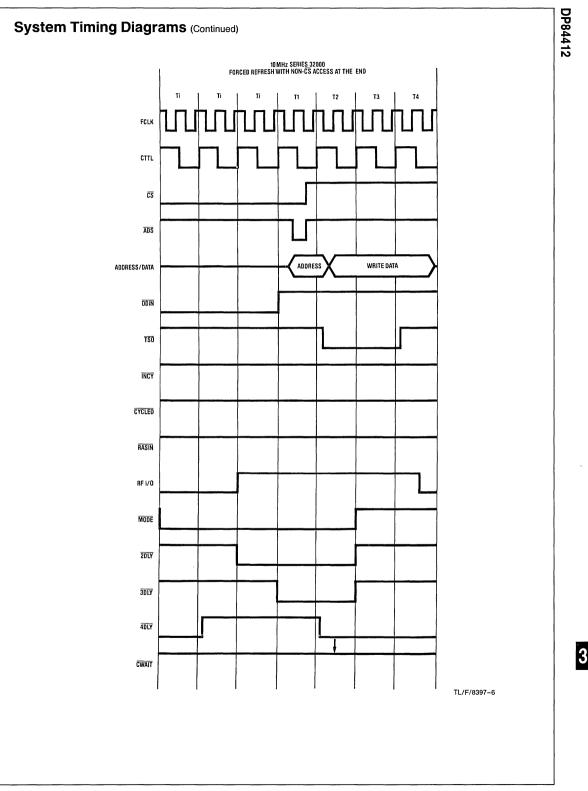




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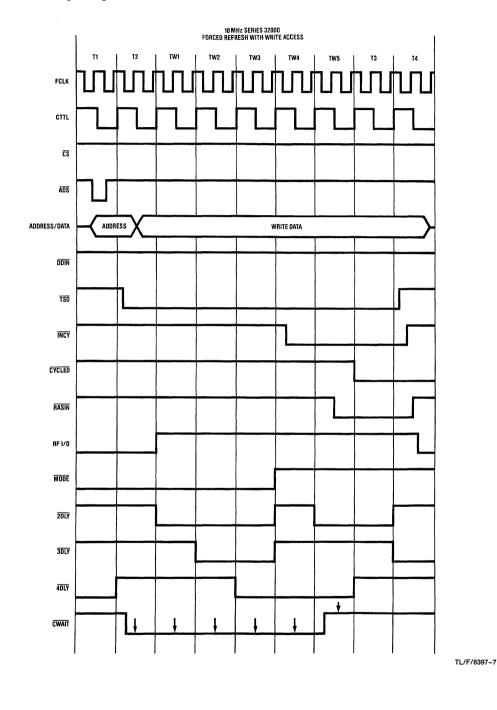
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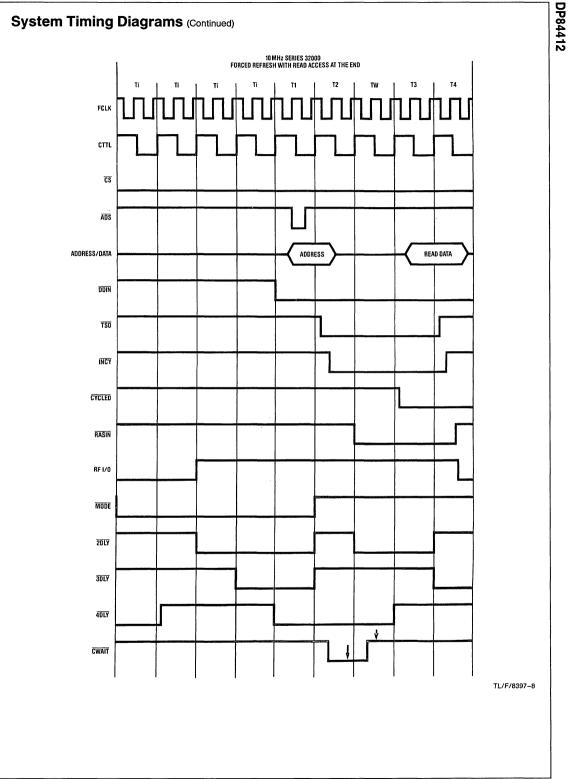


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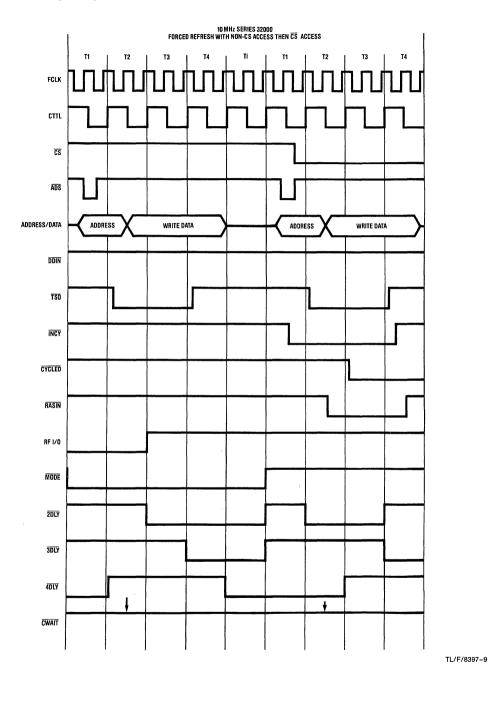
## System Timing Diagrams (Continued)



DP84412



## System Timing Diagrams (Continued)



DP84412

## PRELIMINARY

## National Semiconductor

## DP84422 Dynamic RAM Controller Interface Circuit for the 68000/008/010 CPU(s)

## **General Description**

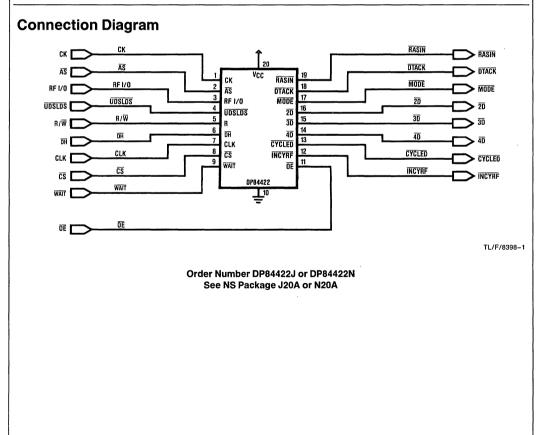
The DP84422 is a new Programmable Array Logic (PAL®) device, that replaces the DP84322, designed to allow an easy interface between the Motorola 68000 family of processors and the National Semiconductor DP8409A, DP8429, or DP8419 DRAM controller.

The new DP84422 supplies all the control signals needed to perform memory read, write, read modify write (as in the Test and Set, "TAS", instruction), and refresh and work with the 68000 family of processors up to 12.5 MHz. Logic is also included to insert WAIT states, if wanted, into the micro-processor READ or WRITE cycles when using fast CPUs.

#### Features

Provides a 3-chip solution for the 68000 family, dynamic RAM interface (DP8409A or DP8419, DP84422, and clock divider).

- Works with all 68000 family speed versions up to 12.5 MHz.—(68008; 68000; and 68010).
- Operation of 68000 processor at 10 MHz with no WAIT states.
- Controls DP8409A or DP8419 Mode 5 accesses, hidden refreshes and Mode 1 Forced Refreshes automatically.
- Inserts WAIT states in READ or WRITE cycles automatically depending on when WAIT is low, or if chip select becomes active during a forced Refresh cycle.
- Uses a standard National Semiconductor PAL part (DMPAL16R4A).
- The PAL logic equations can be modified by the user for his specific application and programmed into any of the PALs in the National Semiconductor family, including the new very high speed PALs ("B" PAL parts).



### **Absolute Maximum Ratings**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

|                                 | Operating | Programming |
|---------------------------------|-----------|-------------|
| Supply Voltage, V <sub>CC</sub> | 7V        | 12V         |
| Input Voltage                   | 5.5V      | 12V         |

Off-State Output Voltage Storage Temperature Range

#### Operating Programming

5.5V 12V -65°C to +150°C

## **Recommended Operating Conditions**

| Symbol          | Parameter Supply Voltage                      |      |      | Units |      |       |
|-----------------|-----------------------------------------------|------|------|-------|------|-------|
| oyinboi         |                                               |      | Min  | Тур   | Max  | Units |
| V <sub>CC</sub> |                                               |      | 4.75 | 5     | 5.25 | ν     |
| tw              | Width of Clock                                | Low  | 15   | 10    |      | ns    |
| w               |                                               | High | 15   | 10    |      |       |
| t <sub>su</sub> | Setup Time from Input<br>or Feedback to Clock |      | 25   | 16    |      | ns    |
| t <sub>h</sub>  | Hold Time                                     |      | 0    | -10   |      | ns    |
| T <sub>A</sub>  | Operating Free-Air Temperature                |      | 0    | 25    | 75   | °C    |
| Тc              | Operating Case Temperature                    |      |      |       |      | °C    |

#### Electrical Characteristics Over Recommended Operating Temperature Range

| Symbol           | Parameter                    | Test Conditions                                    |                              | Min | Тур   | Max   | Units |
|------------------|------------------------------|----------------------------------------------------|------------------------------|-----|-------|-------|-------|
| VIH              | High Level Input Voltage     |                                                    |                              | 2   |       |       | V     |
| VIL              | Low Level Input Voltage      |                                                    |                              |     |       | 0.8   | V     |
| VIC              | Input Clamp Voltage          | V <sub>CC</sub> =Min, I <sub>I</sub> :             | = - 18 mA                    |     | -0.8  | -1.5  | V     |
| V <sub>OH</sub>  | High Level Output Voltage    | $V_{CC} = Min$<br>$V_{IL} = 0.8V$<br>$V_{IH} = 2V$ | I <sub>OH</sub> =-3.2 mA COM | 2.4 | 2.8   |       | v     |
| V <sub>OL</sub>  | Low Level Output Voltage     | $V_{CC} = Min$<br>$V_{IL} = 0.8V$<br>$V_{IH} = 2V$ | I <sub>OL</sub> =24 mA COM   |     | 0.3   | 0.5   | v     |
| lozh             |                              | V <sub>CC</sub> =Max                               | V <sub>O</sub> =2.4V         |     |       | 100   | μΑ    |
| I <sub>OZL</sub> | Off-State Output Current     | V <sub>IL</sub> =0.8V<br>V <sub>IH</sub> =2V       | V <sub>O</sub> =0.4V         |     |       | -100  | μΑ    |
| 4                | Maximum Input Current        | $V_{CC} = Max, V_I = 5.5V$                         |                              |     |       | 1     | mA    |
| ľн               | High Level Input Current     | $V_{CC} = Max, V_1 = 2.4V$                         |                              |     |       | 25    | μΑ    |
| ١ <sub>L</sub>   | Low Level Input Current      | $V_{CC} = Max, V_1 = 0.4V$                         |                              |     | -0.02 | -0.25 | mA    |
| los              | Output Short-Circuit Current | V <sub>CC</sub> =5V                                | V <sub>O</sub> =0V           | -30 | -70   | -130  | mA    |
| lcc              | Supply Current               | V <sub>CC</sub> =Max                               |                              |     | 120   | 180   | mA    |

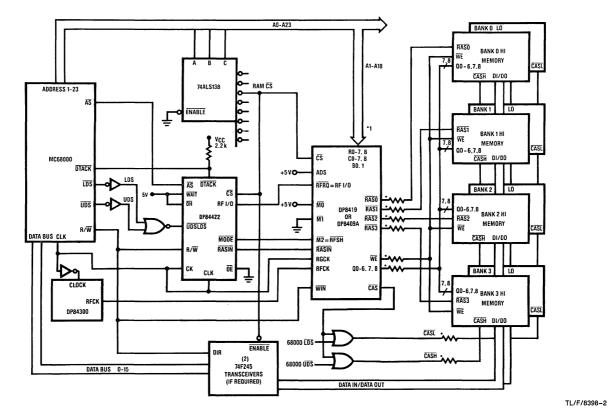
| Symbol           | Parameter                   | Test Conditions<br>R1, R2 | Commercial |     |     | Units |
|------------------|-----------------------------|---------------------------|------------|-----|-----|-------|
| oyinbor          |                             |                           | Min        | Тур | Max | Units |
| t <sub>PD</sub>  | Input or Feedback to Output | CL=50 pF                  |            | 15  | 25  | ns    |
| <sup>t</sup> CLK | Clock to Output of Feedback |                           |            | 10  | 15  | ns    |
| t <sub>PZX</sub> | Pin 11 to Output Enable     |                           |            | 10  | 20  | ns    |
| t <sub>PXZ</sub> | Pin 11 to Output Disable    | C <sub>L</sub> =5 pF      |            | 11  | 20  | ns    |
| t <sub>PZX</sub> | Input to Output Enable      | C <sub>L</sub> =50 pF     |            | 10  | 25  | ns    |
| t <sub>PXZ</sub> | Input to Output Disable     | C <sub>L</sub> =5 pF      |            | 13  | 25  | ns    |
| fMAX             | Maximum Frequency           |                           | 25         | 30  |     | ns    |

ALL IC S DECOUPLED

SERIES DAMPING RESISTERS

\*1 TIE UNUSED ADDRESS LINES TO VCC

This circuit provides direct support of the 68000 Test and Set Instruction using PAGE MODE DRAMs.



3-39

Db84455

#### **Mnemonic Description**

| Mnemonic Description |                                                       |                                                                                                                                                                                                                                                                                     |  |  |  |  |
|----------------------|-------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|
| INP                  | UT SIGNALS                                            |                                                                                                                                                                                                                                                                                     |  |  |  |  |
| 1)                   | "CLK", "CK"                                           | This is the 68000 CPU clock.                                                                                                                                                                                                                                                        |  |  |  |  |
| 2)                   | "AS"                                                  | This is the 68000 address strobe pin.                                                                                                                                                                                                                                               |  |  |  |  |
|                      |                                                       | This signal also tells when the 68000                                                                                                                                                                                                                                               |  |  |  |  |
|                      |                                                       | is in a cycle.                                                                                                                                                                                                                                                                      |  |  |  |  |
| 3)                   | " <u>CS</u> "                                         | This is the chip select signal for the                                                                                                                                                                                                                                              |  |  |  |  |
| 4)                   | "R"                                                   | DP8409A.<br>This is the READ/WRITE pin from the                                                                                                                                                                                                                                     |  |  |  |  |
| -)                   | ""                                                    | 68000.                                                                                                                                                                                                                                                                              |  |  |  |  |
| 5)                   | "RFIO"                                                | This is the RFIO, used as refresh re-<br>quest, from the DP8409A.                                                                                                                                                                                                                   |  |  |  |  |
| 6)                   | "WAIT"                                                | This pin allows the insertion of 1 WAIT<br>state in a $\overline{CS}$ Access cycle if low. As<br>an example; if the user wants 1 WAIT<br>state in READ accesses but 0 WAIT<br>states in WRITE accesses he can in-<br>vert the " $R/\overline{W}$ " input to this input.             |  |  |  |  |
| 7)                   | "UDSLDS"                                              | This input was produced by inverting<br>the two terms UDS and LDS and then<br>logically "NOR"ing them together.<br>This input is low whenever one or both<br>UDS or LDS are low. This pin is used<br>in order to support the 68000 "TAS"<br>instruction. This signal is used in the |  |  |  |  |
| 8)                   | "DH"                                                  | "DTACK" PAL output.<br>This input allows the user to disable<br>the DP8409A/19 hidden refresh, when<br>low, provided he also ties "CS" low on<br>the DP8409A/19. When this input is<br>low "RASIN" is only brought low when<br>a "CS" access ("CS" input to PAL                     |  |  |  |  |
| 9)                   | " <u>OE</u> "                                         | low) is in progress<br>Must be tied low to enable DP84422<br>outputs.                                                                                                                                                                                                               |  |  |  |  |
| OUT                  | PUT SIGNALS                                           |                                                                                                                                                                                                                                                                                     |  |  |  |  |
| 1)                   | "CYCLED"                                              | This signal goes low once a hidden re-<br>fresh or an access has been done as<br>indicated by $\overline{2DLY}$ and $\overline{3DLY}$ being<br>low. This signal goes high once the cy-<br>cle is over as indicated by $\overline{AS}$ going                                         |  |  |  |  |
| 2)                   | "RASIN"                                               | high. See also " $\overline{DH}$ input<br>This signal goes low following $\overline{AS}$ dur-<br>ing an access or hidden refresh. See                                                                                                                                               |  |  |  |  |
| 3)                   | "DTACK"                                               | also "DH" input.<br>This signal causes WAIT states to be<br>inserted into the 68000 processor cy-                                                                                                                                                                                   |  |  |  |  |
| 4)                   | "INCYRF"                                              | cles if it is not low a setup time before<br>S4 falling clock edge.<br>This signal indicates that an access<br>has been requested during a forced<br>refresh cycle. This signal is used to in-<br>sert WAIT states during the foremen-                                              |  |  |  |  |
|                      |                                                       | tioned condition or to prevent a "non- $\overline{\text{CS}}$ " access cycle from automatically                                                                                                                                                                                     |  |  |  |  |
| 5)                   | "MODE"                                                | starting.<br>This signal is used to pull the<br>DP8409A pin M2 low in order to go to                                                                                                                                                                                                |  |  |  |  |
| 6)<br>7)<br>8)       | " <u>2DLY</u> "<br>" <u>3DLY</u> "<br>" <u>4DLY</u> " | mode 1 to do a forced refresh.<br>This signal is an internal delay.<br>This signal is an internal delay.<br>This signal is an internal delay.                                                                                                                                       |  |  |  |  |

#### **Functional Description**

The following description applies to both the DP8409A, DP8429, and the DP8419 dynamic RAM controllers.

A memory cycle starts when chip select (CS) and address strobe ( $\overline{AS}$ ) are true.  $\overline{RASIN}$  is supplied from the DP84422 to the DP8409A dynamic RAM controller, which then supplies a  $\overline{RAS}$  signal to the selected dynamic RAM bank. After the necessary row address hold time, the DP8409A switches the address outputs to the column address. The DP8409A then supplies the required  $\overline{CAS}$  signal to the DR409A then supplies the required  $\overline{CAS}$  signal to the DR409A then supplies the required  $\overline{CAS}$  signal to the DR409A then supplies the required  $\overline{CAS}$  signal to the DR409A. In order to do byte operations it is suggested that the user provide external logic, as shown in the system block diagram, to produce a HIGH CAS and a LOW CAS. To differentiate between a READ and a WRITE, the R/W signal from the CPU is used.

A refresh cycle is started by one of two conditions. The refresh cycle caused by the first condition is called a hidden refresh. This occurs when refresh clock (RFCK) is high, CS is not true, and RASIN goes low. Here the CPU is accessing something else in the system and the DRAM can be refreshed at that time, thereby being transparent to the CPU. The second type of refresh is called forced refresh. This occurs if no hidden refresh was performed while RFCK was high. When RFCK transitions low a refresh request (RFRQ) is generated. If there is not a DRAM access in progress the DP84422 will force a refresh by putting the DP8409A into mode 1 (automatic forced refresh mode). If the CPU tries to access the DRAM during a forced refresh cycle WAIT states will be inserted into its cycles until the forced refresh is over and the DRAM RAS precharge time has been met. Then the pending DRAM access will be allowed to take place.

The DP84422 also allows forced refreshes to take place during long accesses of other devices. For instance, if EEPROM takes several microseconds to write to, the DRAM will still be refreshed while that access is in progress.

In a standard memory cycle, the access can be slowed down by one clock cycle to accommodate slower memories or allow time to generate parity. This is accomplished by inserting a WAIT state into the processor access cycle. The DP84422 can insert WAIT states into either READ cycles, WRITE cycles, READ MODIFY WRITE cycles, or both READ and WRITE cycles or the READ and WRITE portion of a READ MODIFY WRITE cycle. The extra WAIT state will not appear during the hidden refresh cycle, so faster devices on the CPU bus will not be affected.

During a Test and Set instruction  $\overline{CAS}$  is generated twice while  $\overline{RAS}$  is low. In order for this instruction to execute properly Page Mode DRAMs must be used.

### **System Interface Description**

All members of the Motorola 68000 family of processors are able to use the DP84422.

RASIN during a READ cycle will always start at the beginning of the "S3" processor cycle. The user must guarantee that CS is valid a minimum of 34 ns before RASIN becomes valid, unless the PAL "DH" input is low and the DP8409A/ 19 "CS" input is tied low (hidden refresh disabled).

#### System Interface Description (Continued)

Several critical parameters in this application involve the input system CLOCK and the ADDRESS STROBE,  $\overline{AS}$ . These parameters become most critical at higher frequencies (10 MHz and above) where it is suggested that they are directly connected to the corresponding pins of the Motorola 68000 family ICs.

This section of the data sheet goes through the calculation of the "t<sub>RAC</sub>" (RAS access time) and "t<sub>CAC</sub>" (CAS access time) required by the DRAM for the 68000 family CPUs to operate at a particular clock frequency without introducing wait states into the processor access cycles. Both "t<sub>RAC</sub>" and "t<sub>CAC</sub>" must be considered in determining what speed DRAM can be used in a particular system design. The DRAM chosen must meet both the "t<sub>RAC</sub>" and "t<sub>CAC</sub>" parameters calculated. In order to determine the "t<sub>RAC</sub>" and "t<sub>CAC</sub>" needed the DP8419 and fast PALs ("B" type PALs) timing parameters were used. If the user is using the DP8408A/09A or a slower PAL device he should substitute their respective delays into the equation below.

Most all of the calculations contained in this note use "RAHS" = 1 (15 ns guaranteed minimum row address hold time). Calculations only used "RAHS" = 0 (25 ns guaranteed minimum row address hold time) when the calculated access time from RAH exceeded 200 ns. This is because DRAMs can be found with row access times up to 150 ns that require only 15 ns row address hold times.

The calculated "t<sub>RAC</sub>" and "t<sub>CAC</sub>" may differ from the actual system values depending upon the external circuitry used to produce "CASH" and "CASL". The DP8409A/19 "RASIN–CAS" low will be approximately 10–15 ns less than the value given in the data sheet because of the small loading on the DP8409A/19 "CAS" output. The external circuitry needed to produce "CASH, L" should be loaded such that the column address (from DP8409A/19 is valid when "CASH, L" goes low. For this reason "RASIN–CASH, L" may be longer than the value used in the "t<sub>RAC</sub>, t<sub>CAC</sub>" calculations, and therefore may give a smaller "t<sub>RAC</sub>, t<sub>CAC</sub>" then was calculated.

#### **EXAMPLE DRAM TIMING CALCULATIONS**

#### A) 8 MHz 68000, No WAIT States

- #1)  $\overrightarrow{RASIN}$  low = S0 + S1 +  $\overrightarrow{AS}$  low (maximum) + "B" PAL combinational output delay maximum = 125 + 60 + 15 = 220 ns maximum
- #2)  $\overline{RASIN}$  to  $\overline{RAS}$  low = 20 ns maximum
- #3) RASIN to CAS low = 80 ns (DP8419 RASIN CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns
- #4) 74F245 transceiver delay = 7 ns maximum
- #5) CPU data setup time = 15 ns minimum
- " $t_{RAC}$ " = (S0 + S1) + (S2 + S3) + (S4 + S5) + S6 (min) - #1 - #2 - #4 - #5

= 188 ns

$$\label{eq:CAC} \begin{array}{l} ``t_{CAC}'' = (S0 + S1) + (S2 + S3) + (S4 + S5) + S6 \mbox{ (min)} \\ & - \ \#1 - \ \#3 - \ \#4 - \ \#5 \\ & = 125 + 125 + 125 + 55 - 200 - 77 - 7 - 15 \end{array}$$

= 131 ns

Therefore the DRAM chosen should have a " $t_{RAC}$ " less than or equal to 188 ns and a " $t_{CAC}$ " less than or equal to 131 ns. Standard 150 ns DRAMs meet this criteria.

The minimum  $\overline{\text{RAS}}$  PRECHARGE TIME will be approximately one and one half clock periods = 125 + 55 = 180 ns.

The minimum CAS PRECHARGE TIME will be approximately one and one half clock periods plus 35 ns (minimum  $t_{RICL}-t_{RICH}$  for the DP8409-2)=125+55+35=215 ns.

The minimum  $\overline{\text{RAS}}$  PULSE WIDTH will be approximately two clock periods -5 ns (maximum  $t_{RPDL}-t_{RPDH}$  for the DP8409-2) =250-5=245 ns.

The minimum  $\overline{CAS}$  PULSE WIDTH will be approximately two clock periods -70 ns (maximum  $t_{RICL} - t_{RICH}$  for the DP8409-2)=250-70=180 ns.

The smallest pulse widths are generated during WRITE cycles since  $\overrightarrow{RASIN}$  during WRITE cycles starts later than  $\overrightarrow{RASIN}$  during READ cycles.

If one inserted a WAIT state in READ cycles the DRAM column access times, the  $\overline{CAS}$  pulse width, and the  $\overline{RAS}$  pulse width would be increased by one clock period (125 ns in this case). A WAIT state in WRITE cycles would just increase the  $\overline{RAS}$  and  $\overline{CAS}$  precharge by one clock period.

#### B) 10 MHz 68000, No WAIT states

- #1)  $\overrightarrow{RASIN}$  low = S0 + S1 +  $\overrightarrow{AS}$  low (maximum) + "B" PAL combinational output delay maximum = 100 + 55 + 15 = 170 ns maximum
- #2)  $\overline{\text{RASIN}}$  to  $\overline{\text{RAS}}$  low = 20 ns maximum
- #3) RASIN to CAS low = 80 ns (DP8419 RASIN CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns
- #4) 74F245 transceiver delay = 7 ns maximum
- #5) CPU data setup time = 10 ns minimum
- " $t_{RAC}$ " = (S0 + S1) + (S2 + S3) + (S4 + S5) + S6 (min) - #1 - #2 - #4 - #5

$$= 100 + 100 + 100 + 45 - 170 - 20 - 7 - 10$$

$$= 136 \text{ ns}$$
  
"t<sub>CAC</sub>" = (S0 + S1) + (S2 + S3) + (S4 + S5) - S6 (min)  
- #1 - #3 - #4 - #5

$$= 100 + 100 + 100 + 45 - 170 - 77 - 7 - 10$$
  
= 81 ns

Therefore the DRAM chosen should have a " $t_{RAC}$ " less than or equal to 138 ns and a " $t_{CAC}$ " less than or equal to 81 ns. Standard 120 ns DRAMs meet this criteria.

The minimum  $\overline{\text{RAS}}$  PRECHARGE TIME will be approximately one and one half clock periods = 100 + 45 = 145 ns.

The minimum  $\overline{CAS}$  PRECHARGE TIME will be approximately one and one half clock periods plus 35 ns (minimum  $t_{RICL} - t_{RICH}$  for the DP8419)=100+45+35=180 ns.

The minimum  $\overline{RAS}$  PULSE WIDTH will be approximately two clock periods -5 ns (maximum  $t_{RPDL} - t_{RPDH}$  for the DP8419) = 200 - 5 = 195 ns.

The minimum  $\overline{CAS}$  PULSE WIDTH will be approximately two clock periods -50 ns (maximum t<sub>RICL</sub>-t<sub>RICH</sub> for the DP8419)=200-50=150 ns.

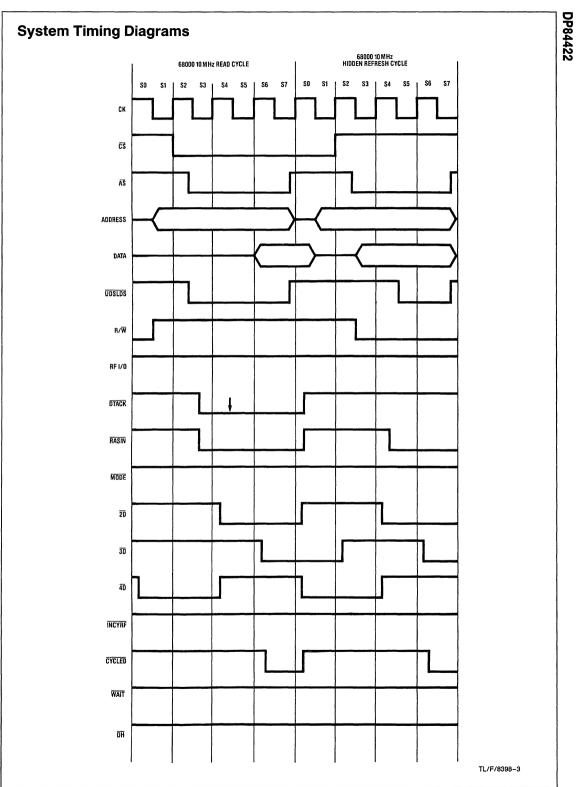
The smallest pulse widths are generated during WRITE cycles since RASIN during WRITE cycles starts later than RASIN during READ cycles.

If one inserted a WAIT state in READ cycles the DRAM column access times, the CAS pulse width, and the RAS pulse width would be increased by one clock period (100 ns in this case). A WAIT state in WRITE cycles would just increase the RAS and CAS precharge by one clock period.

### Interpreting the DP84422 PAL Equations

The boolean equations for the DP84422 were written using the standard PALASM™ format. In other words the equation: "IF (VCC) BASIN = INCY \* MODE \*4D \* B" will mean: The output "RASIN" (see pin list for DP84422) will be active low (inverted RASIN) when the output "INCY" is low (making INCY high) AND the output "MODE" is high AND the output "4D" is low (making 4D high) and the input R/W is low (making R high). PAL16R4A : FAST PAL NEW PAL FOR THE MOTOROLA 68000 PROCESSOR (WORKS UP TO 12.5MHZ) CK /AS RFIO /UDSLDS R /DH CLK /CS /WAIT GND /OE /INCYRF /CYCLED /4DLY /3DLY /2DLY /MODE /DTACK /RASIN VCC IF (VCC) RASIN = CS\*/INCYRF\*AS\*/MODE\*4DLY\*/CYCLED\*/CLK+ :Start RASIN /CS\*/INCYRF\*AS\*/MODE\*2DLY\*/CYCLED\*/DH+ :RASIN for Hidden RFSH CS\*INCYRF\*AS\*/MODE\*4DLY\*/CYCLED\*/CLK+ :Start RASIN after RFSH CS\*RASIN\*/MODE\*AS+ :Hold RASIN valid RASIN\*/MODE\*2DLY ;Hold RASIN valid ;Start "CYCLED", does not allow IF (VCC) CYCLED =/MODE\*2DLY\*3DLY\*/4DLY+ CYCLED\*AS+ : glitch after refresh /MODE\*CYCLED\*/CLK+ End on rising edge of CLK /CS\*AS\*/MODE\*/2DLY\*/3DLY\*/4DLY ;Start during long accesses of other : devices IF (VCC) INCYRF =MODE\*AS+ ;Set Access during Refresh INCYRF\*4DLY\*AS :Hold it while 4DLY is low IF (CS) DTACK = AS\*/WAIT\*/R\*/MODE\*/CLK+ :0 WAIT's for WRITE AS\*WAIT\*/R\*/MODE\*2DLY\*/CLK+ :1 WAIT for WRITE UDSLDS\*/WAIT\*R\*/MODE\*/CLK+ :0 WAIT's for READ :1 WAIT for READ UDSLDS\*WAIT\*R\*/MODE\*2DLY\*/CLK+ DTACK\*2DLY\*/MODE+ :Continue DTACK DTACK\*AS\*RASIN\*/MODE\*/CYCLED+ :Continue DTACK DTACK\*AS\*/R\*/MODE :Continue DTACK in RMW ; cycle MODE : = /RFIO\*/AS\*/CYCLED\*/RASIN+ ;For IDLE states or beginning ; states of 68000 cycle /CS\*/RFIO\*AS\*CYCLED\*/2DLY\*/3DLY\*/RASIN+ ;For RFSH during long cycles ; of other devices MODE \* / 3DLY+ MODE \*/4DLY 2DLY : = MODE \*/4DLY+ /INCYRF\*AS\*/CYCLED\*/MODE\*/3DLY\*4DLY+ :Start 2DLY CS\*INCYRF\*AS\*/CYCLED\*/MODE\*/3DLY\*4DLY+ :Start 2DLY after RFSH /MODE\*2DLY\*/3DLY+ CS\*WAIT\*AS\*/MODE\*2DLY\*3DLY\*/4DLY+ :Make 2DLY longer ;Start second 2DLY for CS\*AS\*/R\*CYCLED\*/MODE\*/2DLY\*/3DLY\*/4DLY the TAS instruction 3DLY : = 2DLY\*/4DLY 4DLY := 3DLY +/AS\*/MODE+ /CS\*/RFIO\*AS\*CYCLED\*/2DLY\*/3DLY\*/RASIN\*/MODE ;Need for beginning of forced refresh to : inhibit "ZDLY"

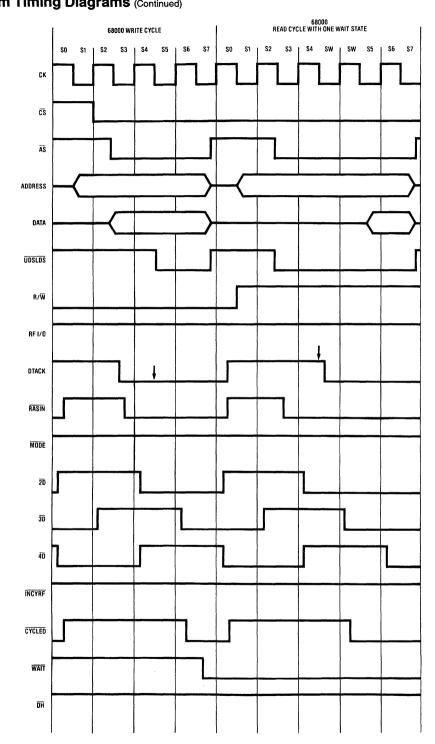
FIGURE 1. Equations for New 68000 PAL That Supports the 68000 "TAS" Instruction



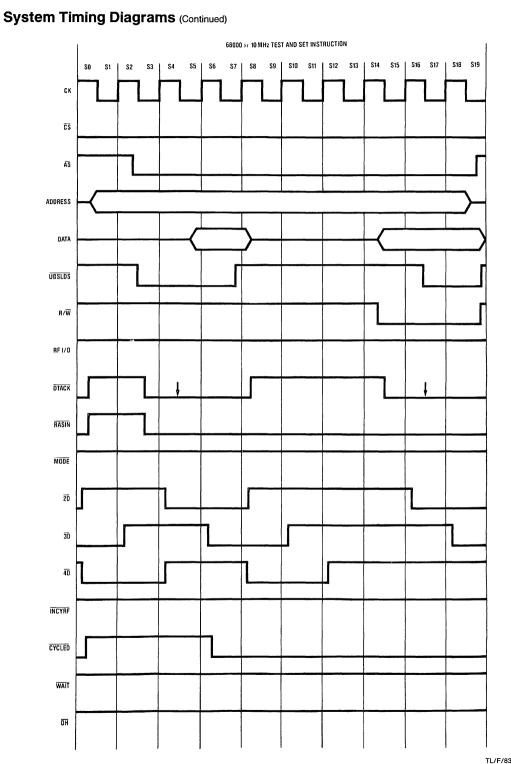
3

# DP84422

# System Timing Diagrams (Continued)



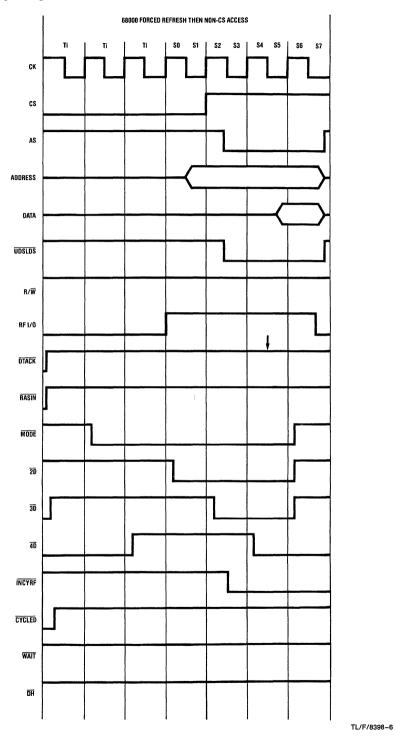
TL/F/8398-4

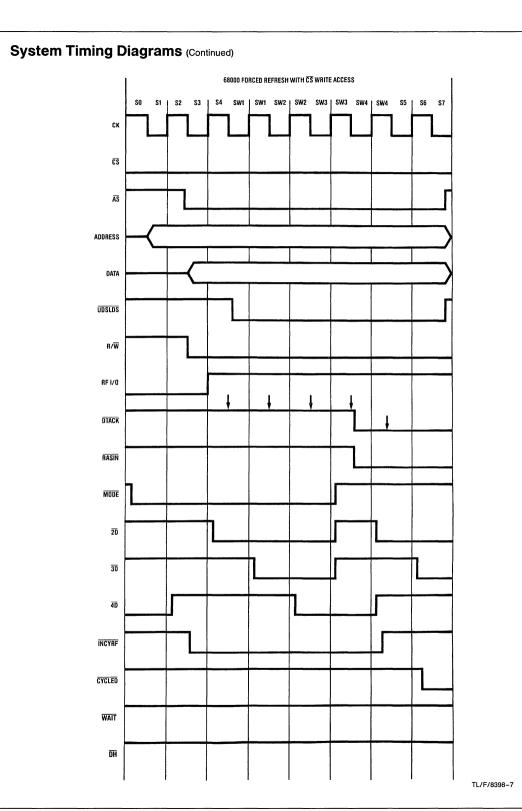


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3

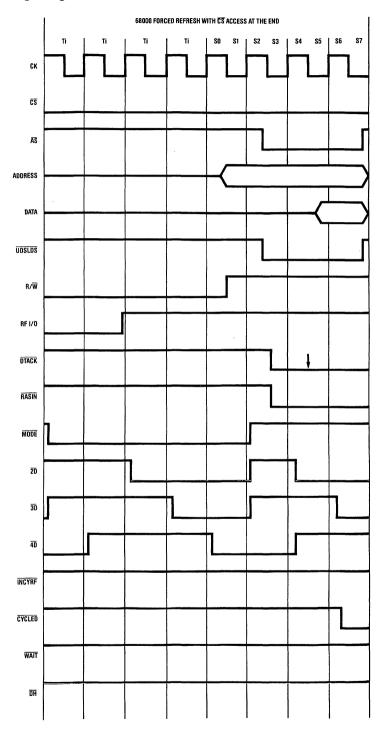
# System Timing Diagrams (Continued)





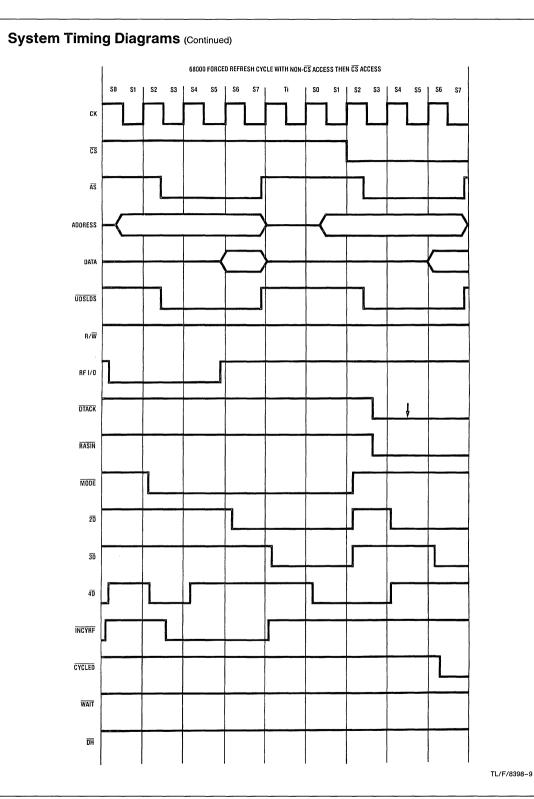
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# System Timing Diagrams (Continued)



DP84422

TL/F/8398-8

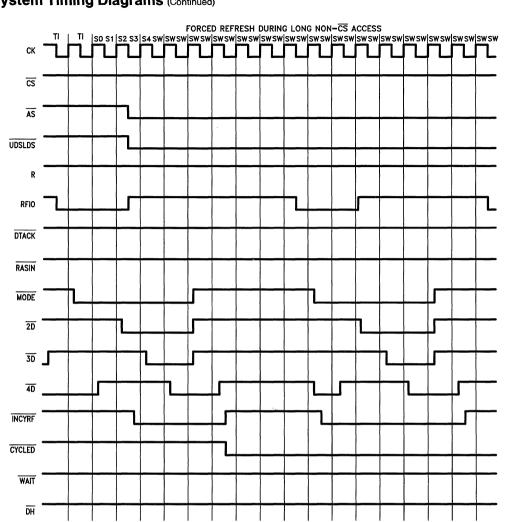


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3

## System Timing Diagrams (Continued)

DP84422



TL/F/8398-10

## PRELIMINARY

# DP84432 Dynamic RAM Controller Interface Circuit for the 8086/8088/80186/80188 CPU's

# **General Description**

National

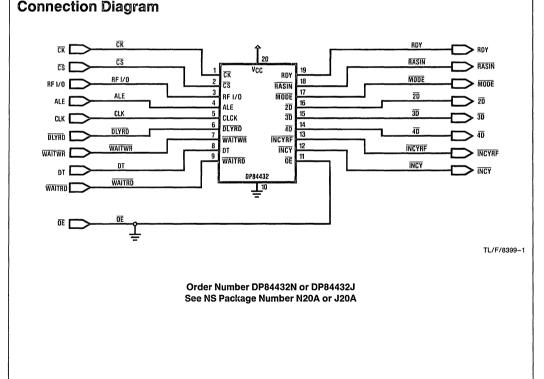
The DP84432 is a new Programmable Array Logic (PAL®) device, that replaces the DP84332, designed to allow an easy interface between the Intel 8088, 8086, 80188, 80186 CPU's and the National Semiconductor DP8409A, DP8429, or DP8419 DRAM controller.

The new DP84432 supplies all the control signals needed to perform memory read, write and refresh and work with the Intel processors up to 10 MHz. Logic is also included to insert WAIT states, if wanted, into the microprocessor READ or WRITE cycles when using fast CPU's.

### Features

Provides a 3-chip solution for the 8086 family, dynamic RAM interface (DP8409A or DP8419, DP84432, and clock divider)

- □ Works with all 8086 family speed versions up to 10 MHz
- □ Operation of 8086, 8088, 80186, 80188 at 10 MHz with no WAIT states
- □ Controls DP8409A or DP8419 Mode 5 accesses, hidden refreshes and Mode 1 Forced Refreshes automatically
- □ Inserts WAIT states in READ or WRITE cycles automatically depending on whether WAITRD or WAITWR are low, or if CS becomes active during a forced Refresh cycle
- Uses a standard National Semiconductor PAL part (DMPAL16R4A)
- The PAL logic equations can be modified by the user for his specific application and programmed into any of the PALs in the National Semiconductor family, including the new very high speed PALs ("B" PAL parts)



3-51

3

### **Absolute Maximum Ratings**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

|                                 | Operating | Programming |
|---------------------------------|-----------|-------------|
| Supply Voltage, V <sub>CC</sub> | • 7V      | 12V         |
| Input Voltage                   | 5.5V      | 12V         |
| Off-State Output Voltage        | 5.5V      | 12V         |
| Storage Temperature Range       | -65°C     | to + 150°C  |

### **DP84432 Recommended Operating Conditions**

| Symbol            | Parameter                                  |                            |      | Commercial |      |       |
|-------------------|--------------------------------------------|----------------------------|------|------------|------|-------|
| oymbol            |                                            |                            | Min  | Тур        | Max  | Units |
| V <sub>CC</sub>   | Supply Voltage                             |                            | 4.75 | 5          | 5.25 | V     |
| tw Width of Clock | Width of Clock                             | Low                        | 15   | 10         |      | ns    |
|                   | High                                       | 15                         | 10   |            |      |       |
| t <sub>su</sub>   | Setup Time from Input or Feedback to Clock |                            | 25   | 16         |      | ns    |
| t <sub>h</sub>    | Hold Time                                  |                            | 0    | - 10       |      | ns    |
| T <sub>A</sub>    | Operating Free-Air Temperature             |                            | 0    | 25         | 75   | °C    |
| T <sub>C</sub>    | Operating Case Temper                      | Operating Case Temperature |      |            |      | °C    |

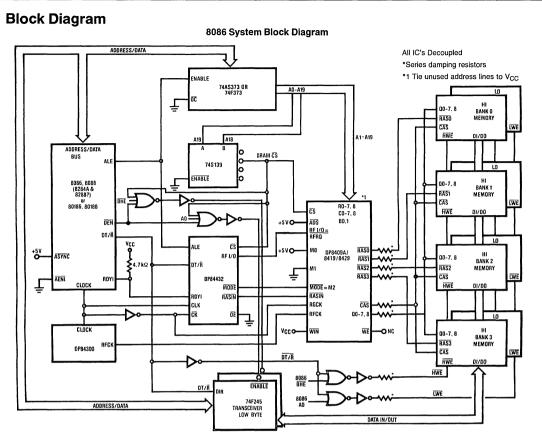
### Electrical Characteristics Over Recommended Operating Temperature Range

| Symbol           | Parameter                    | Te                                                                                                  | st Conditions                  | Min | Тур   | Max   | Units |
|------------------|------------------------------|-----------------------------------------------------------------------------------------------------|--------------------------------|-----|-------|-------|-------|
| VIH              | High Level Input Voltage     |                                                                                                     |                                | 2   |       |       | V     |
| VIL              | Low Level Input Voltage      |                                                                                                     |                                |     |       | 0.8   | V     |
| VIC              | Input Clamp Voltage          | V <sub>CC</sub> = Min., I <sub>I</sub>                                                              | = -18 mA                       |     | -0.8  | - 1.5 | V     |
| V <sub>OH</sub>  | High Level Output Voltage    | $\begin{array}{l} V_{CC} = \text{Min.} \\ V_{IL} = 0.8 \text{V} \\ V_{IH} = 2 \text{V} \end{array}$ | $I_{OH} = -3.2 \text{ mA COM}$ | 2.4 | 2.8   |       | v     |
| V <sub>OL</sub>  | Low Level Output Voltage     | $\begin{array}{l} V_{CC} = \text{Min.} \\ V_{IL} = 0.8 \text{V} \\ V_{IH} = 2 \text{V} \end{array}$ | $I_{OL} = -24 \text{ mA COM}$  |     | 0.3   | 0.5   | v     |
| lozh             | Off Chata Output Ourset      | $V_{CC} = Max$                                                                                      | $V_{O} = 2.4V$                 |     |       | 100   | μA    |
| I <sub>OZL</sub> | Off-State Output Current     | V <sub>IL</sub> = 0.8V<br>V <sub>IH</sub> = 2V                                                      | $V_0 = 0.4V$                   |     |       | - 100 | μA    |
| ų                | Maximum Input Current        | V <sub>CC</sub> = Max., V                                                                           | V <sub>I</sub> = 5.5V          |     |       | 1     | mA    |
| ųн               | High Level Input Current     | V <sub>CC</sub> = Max., '                                                                           | V <sub>I</sub> = 2.4V          |     |       | 25    | μΑ    |
| ١ <sub>١L</sub>  | Low Level Input Current      | V <sub>CC</sub> = Max., V                                                                           | √ <sub>I</sub> = 0.4V          |     | -0.02 | -0.25 | mA    |
| los              | Output Short-Circuit Current | $V_{CC} = 5V$ V                                                                                     | / <sub>O</sub> = 0V            | -30 | -70   | - 130 | mA    |
| Icc              | Supply Current†              | V <sub>CC</sub> = Max.                                                                              |                                |     | 120   | 180   | mA    |

### Switching Characteristics Over Recommended Ranges of Temperature and V<sub>CC</sub>

 $V_{CC}\!=\!5V\!\pm\!10\%$  Commercial:  $T_{A}\!=\!0$  to 75°C,  $V_{CC}\!=\!5V\!\pm\!5\%$ 

| Symbol Parameter | Test Conditions             | Commercial     |     |     | Units |    |
|------------------|-----------------------------|----------------|-----|-----|-------|----|
|                  | R1,R2                       | Min            | Тур | Max | onito |    |
| t <sub>PD</sub>  | Input or Feedback to Output |                |     | 15  | 25    | ns |
| t <sub>CLK</sub> | Clock to Output or Feedback | CL = 50 pF     |     | 10  | 15    | ns |
| t <sub>PZX</sub> | Pin 11 to Output Enable     |                |     | 10  | 20    | ns |
| t <sub>PXZ</sub> | Pin 11 to Output Disable    | $C_L = 5  pF$  |     | 11  | 20    | ns |
| t <sub>PZX</sub> | Input to Output Enable      | $C_L = 50  pF$ |     | 10  | 25    | ns |
| t <sub>PXZ</sub> | Input to Output Disable     | $C_L = 5  pF$  |     | 13  | 25    | ns |
| fMAX             | Maximum Frequency           |                | 25  | 30  |       | ns |



TL/F/8399-2

DP84432

### **Mnemonic Description**

|       |                   | •                                                                      |
|-------|-------------------|------------------------------------------------------------------------|
| INPU' | T SIGNALS         |                                                                        |
| 1)    | "CLOCK"           | Inverted clock from 8284A or 8288.                                     |
|       |                   | "CLOCK" should be delayed from                                         |
|       |                   | CLOCK (pin 5).                                                         |
| 2)    | " <del>CS</del> " | From decoder chip (chip select)                                        |
| ~     |                   | (active low).                                                          |
| 3)    | "ALE"             | From 8086 (active high).                                               |
| 4)    | "RFI/O"           | RFRQ (refresh request) in mode 5.<br>From 8409A, an active low signal. |
| 5)    | "CLOCK"           | The non-inverted clock directly                                        |
| 3)    | OLOOK             |                                                                        |
|       |                   | from the 8284A. This signal should                                     |
|       |                   | be unbuffered to this input so as                                      |
|       |                   | not to incur any extra delay in the                                    |
|       |                   | RASIN generation time.                                                 |
| 6)    | "DELAYREAD"       | This input signal allows the user to                                   |
|       |                   | delay when the RASIN signal be-                                        |
|       |                   | comes valid to the DP8409A during                                      |
|       |                   | a READ cycle of the 8086. This in-                                     |
|       |                   | put should be low when using the                                       |
|       |                   | DP8409A unless an external delay                                       |
|       |                   | line is used to guarantee a 30 ns                                      |
|       |                   | CS to RASIN delay (for DP8409A                                         |
|       |                   |                                                                        |
|       |                   | or 15 ns for DP8419) or if the user                                    |
|       |                   | can afford to disable the hidden re-                                   |
|       |                   | fresh by permanently tying CS low                                      |
|       |                   | on the DP8409A.                                                        |
|       |                   |                                                                        |

7)

8)

"WAITWRITE"

"DT/R"

or "S1" This signal is used to delay when RASIN becomes valid during an 8086 WRITE cycle and also adds a WAIT state into a CS WRITE access cycle. One may want to delay when RASIN becomes valid during a WRITE cycle when generating a parity bit for each byte. This would allow time to generate parity and be assured that the data and parity bit were both written to memory.

Used to differentiate between READ and WRITE cycles, and to allow  $\overline{CS}$  READ cycles to start early. If the system is not a minimum mode 8086 or 8088 system then the status signal " $\overline{S1}$ " should be used instead of "DT/R" so that the DP84432 knows immediately whether the CPU is doing a READ or a WRITE access cycle.

### Mnemonic Description (Continued)

| IALL I   | emonic Des           | SCRIPTION (Continued)                                                                                                                                                                                                                                                                                                                                                                                 |
|----------|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 9)       | "WAITREAD"           | Used to insert 1 wait state into the 8086 READ bus cycle. The wait state following bus cycle "T3" allows the use of memory with longer access times ( $t_{CAC}$ ). An active low signal.                                                                                                                                                                                                              |
| 10)      | " <u>OE</u> "        | This input enables the outputs of<br>the "D-Flip Flop" outputs of the<br>PAL.                                                                                                                                                                                                                                                                                                                         |
| OUT      | PUTS SIGNALS         |                                                                                                                                                                                                                                                                                                                                                                                                       |
| 1)       | "MODE"               | This pin goes to M2 on the DP8409A to change from mode 5 to mode 1 (only used for forced refresh).                                                                                                                                                                                                                                                                                                    |
| 2)       | "2DLY"               | Delay used internal to the PAL.                                                                                                                                                                                                                                                                                                                                                                       |
| 3)       | "3DLY"               | Delay used internal to the PAL.                                                                                                                                                                                                                                                                                                                                                                       |
| 4)       | "4DLY"               | Delay used internal to the PAL.                                                                                                                                                                                                                                                                                                                                                                       |
| 5)<br>6) | "RASIN"              | To the 8409A (creates RAS's).                                                                                                                                                                                                                                                                                                                                                                         |
| 6)       | "RDY1"               | To the 8284A or 8288 to insert wait states into the 8086 bus cy-<br>cles (active low).                                                                                                                                                                                                                                                                                                                |
| 7)       | "INCYCLE<br>REFRESH" | This signal is used in the <i>Figure 1</i><br>PAL to detect that an access cy-<br>cle was started during a DRAM re-<br>fresh cycle. This allows the PAL<br>to determine, later in the cycle,<br>whether the restrict the "INC/CI E"                                                                                                                                                                   |
| 8)       | "INCYCLE"            | whether to restart the "INCYCLE"<br>signal or not. If the CPU is not ac-<br>cessing the DRAM, as determined<br>by "CS" being low, then "INCY-<br>CLE" is not restarted.<br>This signal goes active from the<br>CPU ALE signal. This signal indi-<br>cates that the processor is doing<br>an access somewhere in the sys-<br>tem. This signal stays low for sev-<br>eral T states of the access cycle. |

### **Functional Description**

The following description applies to both the DP8409A and the DP8419 dynamic RAM controllers.

A memory cycle starts when chip select ( $\overline{CS}$ ) and address latch enable (ALE) are true.  $\overline{RASIN}$  is supplied from the DP84432 to the DP8409A dynamic RAM controller, which then supplies a  $\overline{RAS}$  signal to the selected dynamic RAM bank. After the necessary row address hold time, the DP8409A switches the address outputs to the column address. The DP8409A then supplies the required  $\overline{CAS}$  signal to the DRAM. In order to do byte operations it is suggested that the user provide external logic, as shown in the system block diagram, to produce a HIGH WRITE ENABLE or a LOW WRITE ENABLE. To differentiate between a READ and a WRITE, the DT/ $\overline{R}$  (or status signal " $\overline{S1}$ " in a maximum mode 8086 or 8088 system or in a 80186, 8188 system) signal from the CPU is inverted and also supplied to the external WRITE ENABLE logic.

A refresh cycle is started by one of two conditions. The refresh cycle caused by the first condition is called a hidden refresh. This occurs when refresh clock (RFCK) is high,  $\overline{CS}$  is not true, and  $\overline{RASIN}$  goes true. Here the CPU is accessing something else in the system and the DRAM can be refreshed at that time, thereby being transparent to the CPU. The second type of refresh is called forced refresh. This

occurs if no hidden refresh was performed while RFCK was high. When RFCK transitions low a refresh request (RFRQ) is generated. If there is not a DRAM access in progress the DP84432 will force a refresh by putting the DP8409A into mode 1 (automatic forced refresh mode). If the CPU tries to access the DRAM during a forced refresh cycle WAIT states will be inserted into its cycles until the forced refresh is over and the DRAM RAS precharge time has been met. Then the pending DRAM access will be allowed to take place.

The DP84432 also allows forced refreshes to take place during long accesses of other devices. For instance, if EEPROM takes several microseconds to write to, the DRAM will still be refreshed while that access is in progress.

In a standard memory cycle, the access can be slowed down by one clock cycle to accommodate slower memories or allow time to generate parity. This is accomplished by inserting a WAIT state into the processor access cycle. The DP84432 can insert WAIT states into either READ or WRITE cycles, or both. The extra WAIT state will not appear during the hidden refresh cycle, so faster devices on the CPU bus will not be affected.

### SYSTEM INTERFACE DESCRIPTION

The 80186 or 80188 will be able to use the DP84432 but it will be necessary to invert "ALE" of the 80186 or 80188 and logically NOR it with the "CLOCK" signal. This fix makes the 80186 or 80188 "ALE" signal appear to be similar to the 8086 or 8088 "ALE" signal. The 8088 will be able to use this PAL, but the 8088 will not need the logic necessary to produce LWE, HWE. The 80286 can not use this PAL because it's WAIT state logic is different. (See DP84532 data sheet).

The DP84432 differentiates between READ and WRITE cycles, allowing the  $\overline{\text{RASIN}}$  signal to start earlier during a READ cycle compared to a WRITE cycle.

RASIN during a READ cycle can start during T1 or T2 of a processor cycle depending on whether the DELAYREAD input is set low or high. If DELAYREAD is false the user will need to use an external delay line to guarantee that CS will be valid a minimum of 30 ns before RASIN becomes true. If the user is willing to give up hidden refreshes (CS tied permanently low on DP8409A) he must only guarantee that the addresses are valid at the inputs of the DP8409A by a minimum of 10 ns before RASIN becomes valid.

This section of the data sheet goes through the calculation of the "tRAC" (RAS access time) and "tCAC" (CAS access time) required by the DRAM for the iAPX 86/88/186/188 family CPUs to operate at a particular clock frequency without introducing wait states into the processor access cycles. Both "tRAC" and "tCAC" must be considered in determining what speed DRAM can be used in a particular system design. The DRAM chosen must meet both the "tRAC" and "tCAC" parameters calculated. In order to determine the "tRAC" and "tCAC" needed the DP8419 and fast PALs ("B" type PALs) timing parameters were used. If the user is using the DP8408A/09A or a slower PAL device he should substitute their respective delays into the equations below.

Most all of the calculations contained in this note use "RAHS" = 1 (15 ns guaranteed minimum row address hold time). Calculations only used "RAHS" = 0 (25 ns guaranteed minimum row address hold time) when the calculated access time from RAS exceeded 200 ns. This is because DRAMs can be found with row access times up to 150 ns that require only 15 ns row address hold times.

### Functional Description (Continued)

### EXAMPLE DRAM TIMING CALCULATIONS

A) iAPX 86/88 8 MHz , No WAIT states, "/DLYRD" = low

- #1) RASIN low=1 system clock period+15 ns ("B" PAL combinational output delay) = 125+15=140 ns maximum
- #2) RASIN to RAS low=20 ns maximum
- #3)  $\overrightarrow{RASIN}$  to  $\overrightarrow{CAS}$  low=80 ns (DP8419  $\overrightarrow{RASIN} \overrightarrow{CAS}$ low)-3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet)=77 ns maximum (using 15 ns minimum row address hold time)
- #4) 74F245 transceiver delay = 7 ns maximum
- #5) CPU data setup time to "T4"=20 ns minimum

"
$$t_{BAC}$$
" = T1 + T2 + T3 - #1 - #2 - #4 - #5

$$= 125 + 125 + 125 - 140 - 20 - 7 - 20 = 188 \text{ ns}$$

$$t_{CAC} = T1 + T2 + T3 - #1 - #3 - #4 - #5$$

$$= 125 + 125 + 125 - 140 - 77 - 7 - 20 = 131$$
 ns

Therefore the DRAM chosen should have a "tRAC" less then or equal to 188 ns and a "t<sub>CAC</sub>" less then or equal to 131 ns. Standard 150 ns DRAMs meet this criteria.

The minimum RAS PRECHARGE TIME will be approximately two clock periods = 125 + 125 = 250 ns.

The minimum CAS PRECHARGE TIME will be approximately two clock periods plus 50 ns (minimum tRICL-tRICH for the DP8409-2) = 125 + 125 + 50 = 300 ns.

The minimum RAS PULSE WIDTH will be approximately two clock periods-5 ns (t<sub>RPDL</sub>-t<sub>RPDH</sub> for the DP8409-2) = 125 + 125 - 5 = 245 ns.

The minimum CAS PULSE WIDTH will be approximately two clock periods -70 ns (maximum  $t_{RICL}$ - $t_{RICH}$  for the DP8409-2) = 125 + 125 - 70 = 180 ns.

The above times are assuming the use of the DP8409-2 and a fast ("A" part) PAL. The smallest pulse widths are generated during WRITE cycles since RASIN during WRITE cvcles starts later than RASIN during READ cycles.

### B) 80186, 8 MHz, "DLYRD" = HIGH, No Hidden Refresh $(\overline{CS} = Low)$ , No Wait States

Minimum RASIN=55 ns (min clk low)+1 ns (min PAL delay)=68 ns

Maximum Address Valid=44 ns (ADD valid max)+8 ns (74F373) = 52 ns

- #1) RASIN low=Maximum clock high+15 ns ("B" PAL combinational output delay)=70+15=85 ns maximum
- #2)  $\overrightarrow{RASIN}$  to  $\overrightarrow{RAS}$  low = 20 ns maximum
- #3) RASIN to CAS low=97 ns (DP8419 RASIN-CAS low)-3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 94 ns maximum (using 25 ns minimum row address hold time)
- #4) 74F245 Transceiver delay = 7 ns maximum
- #5) CPU data setup time to "T4"=20 ns minimum

"
$$t_{RAC}$$
" = T1 + T2 + T3 - #1 - #2 - #4 - #5

$$= 125 + 125 + 125 - 85 - 20 - 7 - 20 = 243 \text{ ns}$$
 "t<sub>CAC</sub>" = T1 + T2 + T3 - #1 - #3 - #4 - #5

$$C^{-} = 11 + 12 + 13 - #1 - #3 - #4 - #5$$

= 125 + 125 + 125 - 85 - 94 - 7 - 20 = 169 ns

Therefore the DRAM chosen should have a "tRAC" less then or equal to 243 ns and a "t<sub>CAC</sub>" less then or equal to 169 ns. Standard 200 ns DRAMs meet this criteria.

The minimum RAS PRECHARGE TIME will be approximatelv one clock period+55 ns (minimum clock low)-15 ns (maximum DP84432 clocked output delay for ending  $\overline{RASIN}$  = 125 + 55 - 15 = 165 ns.

The minimum CAS PRECHARGE TIME will be approximately one clock period+55 ns (minimum clock low)-15 ns (maximum clocked output delay for ending RASIN) + 35 ns (minimum tRICL-TRICH for the DP8409-2) = 125 +55-15+35=200 ns.

The minimum RAS PULSE WIDTH will be approximately two clock periods-5 ns (t<sub>RPDL</sub>-t<sub>RPDH</sub> for the DP8409-2) = 125 + 125 - 5 = 245 ns.

The minimum CAS PULSE WIDTH will be approximately two clock periods-70 ns (maximum t<sub>RICL</sub>-t<sub>RICH</sub> for the DP8409-2) = 125 + 125 - 70 = 180 ns.

### C) 8086, 8 MHz, CS Tied Low (no hidden refresh), DLYRD = HIGH, No Delay Line Needed, No Wait States

Minimum RASIN=69 ns (min clk low)+13 ns (min PAL delav) = 82 ns

Maximum Address Valid=60 ns (ADD valid max)+8 ns (74F373) = 68 ns

The address must be valid a minimum of 10 ns before RASIN goes valid at the inputs of the DP8409A or DP8419, which it will be given the ICs used in this example.

- #1) RASIN low=Maximum clock high+15 ns ("B" PAL combinational output delay) = 82 + 15 = 97 ns maximum
- #2) RASIN to RAS low=20 ns maximum
- #3)  $\overrightarrow{RASIN}$  to  $\overrightarrow{CAS}$  low = 97 ns (DP8419  $\overrightarrow{RASIN}$   $\overrightarrow{CAS}$ low)-3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 94 ns maximum (using 25 ns minimum row address hold time)
- #4) 74F245 Transceiver delay = 7 ns maximum
- #5) CPU data setup time to "T4"=20 ns minimum

"
$$t_{BAC}$$
" = T1 + T2 + T3 - #1 - #2 - #4 - #5

= 125 + 125 + 125 - 97 - 20 - 7 - 20 = 231 ns

"t<sub>CAC</sub>" = T1 + T2 + T3 - #1 - #3 - #4 - #5

Therefore the DRAM chosen should have a "tBAC" less then or equal to 231 ns and a "t<sub>CAC</sub>" less then or equal to 157 ns. Standard 200 ns DRAMs meet this criteria.

The minimum RAS PRECHARGE TIME will be approximately one clock period+69 ns (minimum clock low)+15 ns (maximum DP84432 clocked output delay for ending  $\overline{\text{RASIN}}$  = 125 + 69 - 15 = 179 ns.

The minimum CAS PRECHARGE TIME will be approximately one clock period+69 ns (minimum clock low)-15 ns (maximum clocked output delay for ending RASIN) + 35 ns (minimum tRICL-TRICH for the DP8409-2) = 125 +69-15+35=214 ns.

The minimum RAS PULSE WIDTH will be approximately two clock periods -5 ns (t<sub>RPDL</sub>-t<sub>RPDH</sub> for the DP8409-2) =125+125-5=245 ns.

The minimum CAS PULSE WIDTH will be approximately two clock periods-70 ns (maximum t<sub>RICL</sub>-t<sub>RICH</sub> for the DP8409-2) = 125 + 125 - 70 = 180 ns.

### Functional Description (Continued)

### D) 8086, 10 MHz, CS Tied Low (no hidden refresh), DLYRD = HIGH, No Delay Line Needed, No Wait States MINIMUM $\overline{\text{RASIN}} = 52 \text{ ns}$ (min clk low) + 13 ns (min PAL delay) = 65 nsMAXIMUM ADDRESS VALID = 50 ns (ADD valid max) + 8 ns (74F373) = 58 nsThe address must be valid a minimum of 10 ns before RASIN goes valid at the inputs of the DP8409A or DP8419. As an example use two 74ALS04 inverters to guarantee a minimum delay of 4 ns. therefore MINIMUM RASIN = 69 ns #1) RASIN low = Maximum clock high + 15 ns ("B" PAL combinational output delay) = 61 + 15 = 76 ns maximum #2) $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ low = 20 ns maximum #3) $\overline{\text{RASIN}}$ to $\overline{\text{CAS}}$ low = 80 ns (DP8419 $\overline{\text{RASIN}}$ - $\overline{\text{CAS}}$ low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns maximum (using 15 ns minimum row address hold time) #4) 74F245 Transceiver delay = 7 ns maximum #5) CPU data setup time to "T4" = 5 ns minimum " $t_{\text{RAC}}$ " = T1 + T2 + T3 - #1 - #2 - #4 - #5

$$"t_{CAC}" = T1 + T2 + T3 - \#1 - \#3 - \#4 - \#5$$

$$= 100 + 100 + 100 - 76 - 77 - 7 - 5 = 135 \text{ ns}$$

Therefore the DRAM chosen should have a "t<sub>RAC</sub>" less then or equal to 192 ns and a "t<sub>CAC</sub>" less then or equal to 135 ns. Standard 150 ns DRAMs meet this criteria.

The minimum  $\overline{\text{RAS}}$  PRECHARGE TIME will be approximately one clock period + 69 ns (minimum clock low) - 15 ns (maximum DP84432 clocked output delay for ending  $\overline{\text{RASIN}}$ ) = 125 + 69 - 15 = 179 ns.

The minimum  $\overline{\text{CAS}}$  PRECHARGE TIME will be approximately one clock period + 69 ns (minimum clock low) - 15 ns (maximum clocked output delay for ending  $\overline{\text{RASIN}}$ ) + 35 ns (minimum t<sub>RICL</sub>-t<sub>RICH</sub> for the DP8409-2) = 125 + 69 - 15 + 35 = 214 ns.

The minimum  $\overline{\text{RAS}}$  PULSE WIDTH will be approximately two clock periods -5 ns (t<sub>RPDL</sub>-t<sub>RPDH</sub> for the DP8409-2) = 125 + 125 - 5 = 245 ns.

The minimum  $\overline{CAS}$  PULSE WIDTH will be approximately two clock periods - 70 ns (maximum  $t_{RICL}$ - $t_{RICH}$  for the DP8409-2) = 125 + 125 - 70 = 180 ns.

### SUGGESTIONS

It is suggested that the DP8409A is to be used up to 8 MHz. Above 8 MHz one should use the DP8409-2 or the DP8419. Also fast PALs ("A" parts) should be used at 8 MHz and above. If very fast PALs are used ("B" parts) the access will be 10 ns faster than calculated in the above sections.

These suggestions occur because of DRAM parameters that must be met, such as:

- 1) CAS ACCESS TIME—time from CAS valid until data is available at the DRAM outputs.
- 2) RAS PRECHARGE TIME—minimum amount of time from RAS high until RAS transitions low again.

- 3) CAS PRECHARGE TIME—minimum amount of time from CAS high until CAS transitions low again.
- 4) RAS PULSE WIDTH—minimum RAS valid time during an access, this usually occurs during a WRITE operation since RASIN is generated later then in a READ operation.
- CAS PULSE WIDTH—minimum CAS valid time during an access.
- 6) DATA IN SETUP TIME—the data, during a DRAM WRITE access cycle, must be valid at the DRAM inputs when WRITE ENABLE or CAS transitions low, whichever occurrs last.

For instance, during a WRITE operation, one does not want CAS to go valid until the data to be written is setup at the inputs to the dynamic RAM. Therefore an 8086 running at 5 MHz should use a DP8409A and a slower DP84432 PAL. EXAMPLE: 8086, 5 MHz, DP8409A, DP84432 (fast PAL "A" part)

MINIMUM  $\overline{\text{HASIN}} = 3$  ns (min clk inversion) + 7 ns (min fast PAL clocked output) + 13 ns (min combinational fast PAL output) = 23 ns into the T2 CPU cycle.

MINIMUM DATA VALID during an 8086 WRITE at 5 MHz = 110 ns

Therefore, worst case, the data could be valid 1 ns before  $\overline{CAS}$  becomes valid at the DRAM inputs. Most DRAMs specify 0 ns setup time so this is OK, but if the DP8409A is driving less then the full load specified in the data sheet  $\overline{CAS}$  could become valid before the data was available at the DRAM inputs. Therefore the user may want to use a slower PAL or adjust the PAL equations to start the WRITE later in the access cycle. For example, the second equation in the  $\overline{RASIN}$  term could be adjusted as follows to accomplish a later  $\overline{RASIN}$  during WRITE cycles:

change "CS\*INCY\*MODE\*2D\*WAITWR" to

"CS\*INCY\*MODE\*2D\*WAITWR\*CLK"

At higher frequencies one generally wants to generate WRITE as the DP84432 does in order to guarantee that the CAS pulse width is great enough.

### INTERPRETING THE DP84432 PAL EQUATIONS

The boolean equations for the DP84432 were written using the standard PALASM™ format. In other words the equation:

"IF (VCC) RASIN = INCY\*MODE\*4D\*DT" will mean;

The output "RASIN" (see pin list for DP84432) will be active low (inverted RASIN) when the output "INCY" is low (making INCY high) AND the output "MODE" is high AND the output " $\overline{4D}$ " is low (making 4D high) AND the input DT/R is low (making  $\overline{DT/R}$  high).

# DP84432

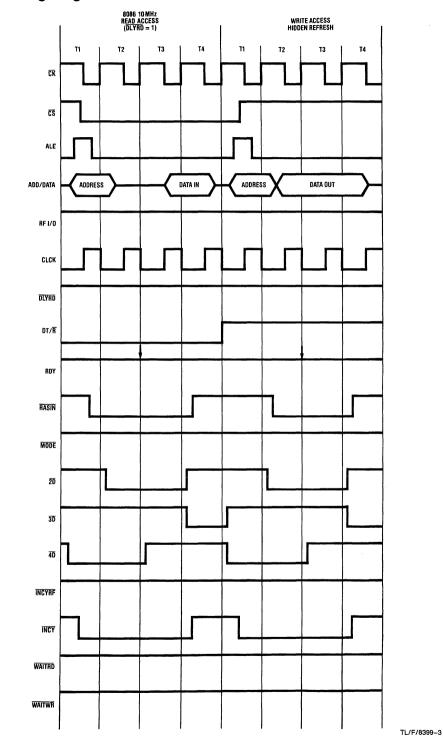
**PAL Boolean Equations** PAL16R4A :FAST PAL NEW PAL FOR INTEL PROCESSORS 8086, 8088, 80186, 80188 NATIONAL SEMICONDUCTOR (WORKS UP TO 10 MHz) CK CS RF10 ALE CLK DLYRD WAITWR DT WAITRD GND OE INCY INCYRF 4D 3D 2D MODE RASIN RDY VCC IF (VCC) RASIN = INCY\*MODE\*4D\*DT\*DLYRD\*CLK+ ;Start RASIN, early READ CS\*INCY\*MODE\*2D\*WAITWR+ ;Start RASIN, early WRITE CS\*INCY\*INCYRF\*ALE\*MODE\*3D\*DT\*CLK+ :Start READ CS\*INCY\*MODE\*2D\*DT\*WAITWR\*CLK+ :Late WRITE CS\*INCY\*MODE\*2D+ :Hidden RFSH RASIN\*INCY\*ALE\*MODE\*3D\*4D+ :Continue RASIN RASIN\*MODE\*2D :Continue RASIN ;Start INCYCLE in REFRESH IF (VCC) INCYRF = ALE\*MODE+ INCYRF\*MODE+ :Continue INCY in REFRESH INCYRF\*4D\*CLK ;Continue INCY in REFRESH MODE :=  $\overline{\text{RF10}}*\overline{\text{INCY}}*\overline{\text{2D}}+$ ;Forced RFSH at beginning ; of a cycle, during IDLE  $MODE^*\overline{3D}+$ ; states, or during long  $MODE * \overline{4D}$ : accesses of other devices  $2D := MODE^*\overline{4D} +$ INCY\*MODE\*4D+  $CS^*\overline{DT}^*WAITRD^*INCY^*\overline{MODE}^*2D^*\overline{3D}^*\overline{4D}+$ Extend for "CS READ" cycle CS\*DT\*WAITWR\*INCY\*MODE\*2D\*3D\*4D :Extend for "CS WRITE" cvcle  $3D := 2D^*\overline{4D}$ 4D := 3D+ INCY \* MODE+ INCY\*MODE\*2D IF (VCC) INCY =  $ALE*\overline{MODE}$ + Start INCY for access

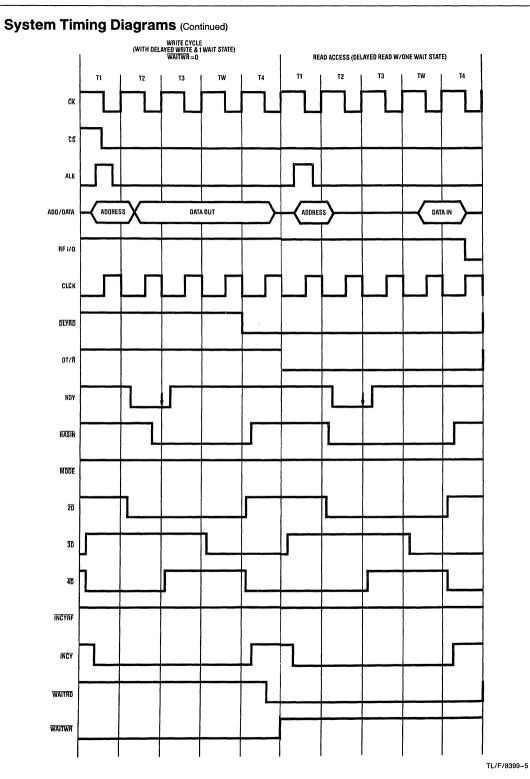
- INCY\*INCYRF\*MODE\*3D\*4D+ ;Continue INCY during access INCY\*MODE\*2D+ ;End INCY during access CS\*INCYRF\*MODE\*2D\*3D\*4D+ :Start INCY after REFRESH CS\*INCY\*MODE\*3D\*4D\*RDY ;Continue INCY after REFRESH
- IF (CS)  $\overline{RDY} = CS^*INCYRF^*\overline{2D}^*\overline{3D}^*4D+$ :Access at end of RFSH cycle CS\*RDY\*MODE\*2D\*3D\*4D+ :Continue RDY after RFSH CS\*MODE+ :Continue RDY after RFSH CS\*DT\*WAITRD\*INCY\*MODE\*2D\*3D\*4D+ ;WAIT for "CS READ" CS\*DT\*WAITWR\*INCY\*MODE\*2D\*3D\*4D ;WAIT for "CS WRITE"

FIGURE 1. Equations for the DP84432 Standard Interface PAL (Works in Minimum or Maximum Mode)

# DP84432

## **System Timing Diagrams**





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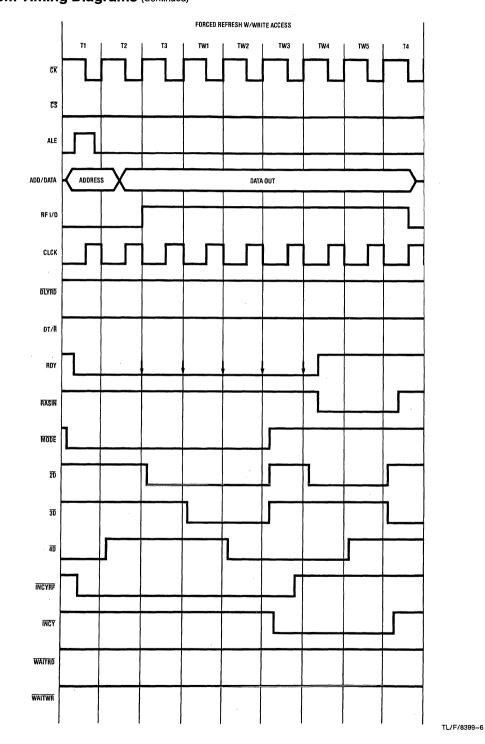
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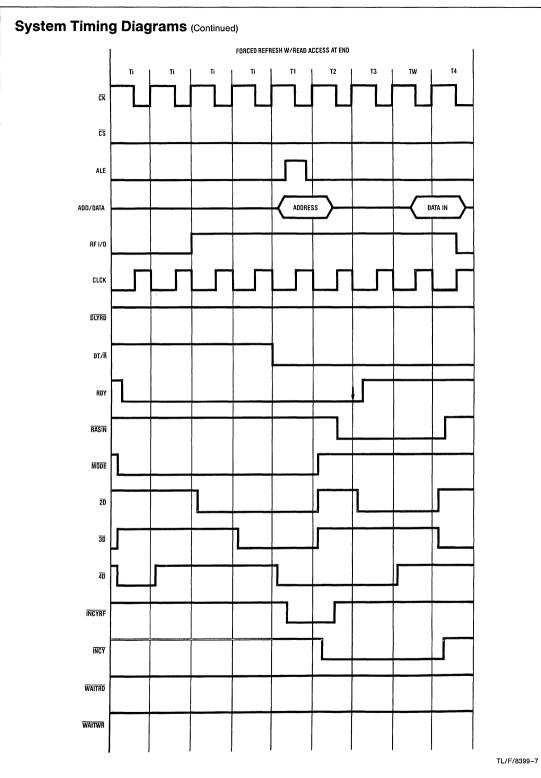
3-59

DP84432

3

# System Timing Diagrams (Continued)





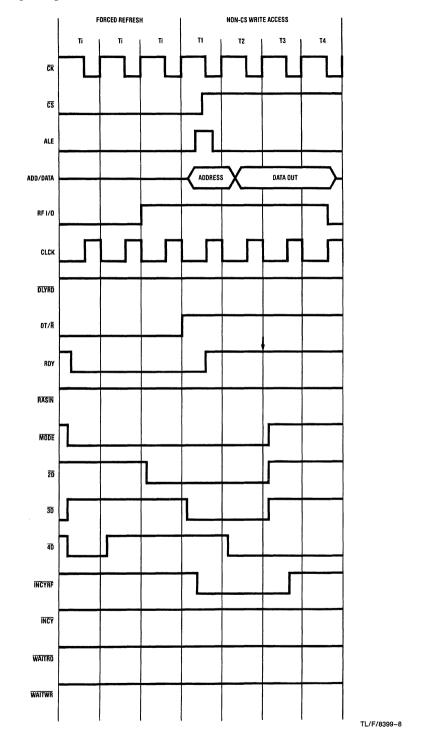
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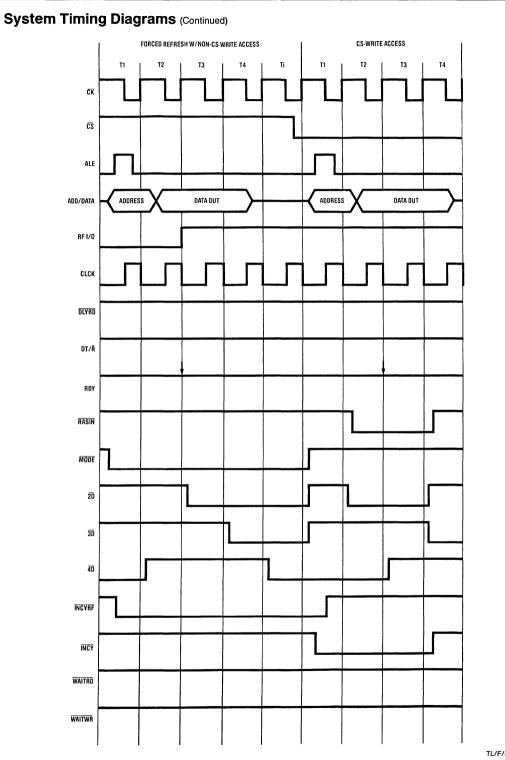
DP84432

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# DP84432

# System Timing Diagrams (Continued)





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3-63

3



# DP84512 Dynamic RAM Controller Interface Circuit for the NS32332

## **General Description**

This is a PAL (Programmable Array Logic) device designed to allow an easy interface between the National Semiconductor NS32332 microprocessor and the National Semiconductor DP8417/18/19/28/29 dynamic RAM controller.

This PAL supplies all the control signals needed to perform memory read, burst read, write, and refresh operations up to a frequency of 15 MHz.

### Features

- Provides a 3-chip solution for the NS32332/DP8418 (or DP8428) dynamic RAM interface (1 PAL, DP8418 and clock divider)
- Works with all speed versions of the NS32332 up to 15 MHz

- Allows operation of NS32332 at 12 MHz with no WAIT states with standard 120 ns 256k or 1M DRAMs
- Controls DP8417/18/19/28/29 mode 5 accesses and mode 0 forced refreshes automatically
- Allows READ accesses in burst mode
- CPU WAIT states are automatically inserted during contention between DRAM accesses and DRAM refreshes
- Uses standard National Semiconductor PALs (i.e., DMPAL16R4A, the user may want to use faster versions of these PALs at higher CPU operating frequencies)
- The PAL programming equations are provided with comments for easy user modification to his specific requirements

# DP84522 Dynamic RAM Controller Interface Circuit for the 68020 CPU

## **General Description**

National

This is a Programmable Array Logic (PAL®) device designed to allow an easy interface between the 68020 microprocessor and the National Semiconductor DP8417, DP8418, DP8419, DP8428 or DP8429 dynamic memory controllers.

This PAL supplies all the control signals needed to perform memory read, write, and refresh operations up to a frequency of 16.7 MHz.

### Features

- Provides a 3 or 4 chip solution for the 68020/DP8418 (or DP8428) dynamic RAM interface (1 or 2 PALs, DP8418, and clock divider)
- $\blacksquare$  Works with all speed versions of the 68020 up to 16.7 MHz
- Allows operation of 68020 at 12.5 MHz with 1 WAIT state with standard 120 ns 256k DRAMs
- □ Controls DP8418/28 mode 5 accesses and mode 1 or 0 forced refreshes automatically
- Allows memory interleaving if desired
- CPU WAIT states are automatically inserted during contention between memory interleaving/DRAM accesses/ DRAM refreshes
- Uses standard National Semiconductor PALs (i.e., DMPAL16R4A; the user may want to use faster versions of these PALs at higher CPU operating frequencies)
- The PAL programming equations are provided with comments for easy user modification to his specific requirements

### **Functional Description**

The following description applies only to the DP8418 or DP8428 since "RFI/O" going low initiates a mode 0 externally controlled forced refresh. This forced refresh resets the internal refresh request logic on the DP8418 or DP8428, but will not reset the internal logic on the DP8409A.

A memory cycle starts when chip select ( $\overline{CS}$ ) and the address strobe ( $\overline{AS}$ ) become true.  $\overline{RASIN}$  is supplied from the PALs to the DP8418 DRAM controller, which then supplies  $\overline{RAS}$  to the selected  $\overline{RAS}$  bank. After the necessary row address hold time, the DP8418 switches the address outputs to the column address. The DP8418 then supplies the required  $\overline{CAS}$  signal to the DRAM.

The first PAL (PAL #1) supports byte operations by producing four WRITE enables, one for each possible byte of the 32 bit word (upper, upper middle, lower middle, and lower write enable). These WRITE enables are produced externally from the 68020 "DATA STROBE" and "READ/WRITE" outputs. Since it is possible that all WRITE cycles may be LATE WRITE cycles ("WRITE ENABLE" occurring after "COLUMN ADDRESS STROBE") memory buffers should be used instead of transceivers to separate the data in from the data out of the DRAMs.

The second PAL (PAL #2) supports byte operations by producing four COLUMN ADDRESS STROBES, one for each of the possible bytes of the 32-bit word. This PAL terminates the DP8418 "RASIN" input early but holds the DRAM data valid by latching the byte "CAS's" externally. This method of supporting byte writes allows transceivers to be used, or to directly connect the DRAM data in and data out pins to the 68020 data bus I/O pins.

Hidden REFRESH cycles are not allowed in this set of PALs because of the need for adequate  $\overrightarrow{\text{RAS}}$  precharge times in all circumstances and the desire not to be inserting WAIT states into access cycles of other system elements.

These PALs perform externally controlled forced refreshes automatically (mode 0). A refresh cycle occurs when the DP8418 input RFCK transitions low and the RFIO signal goes low requesting a refresh cycle. The PAL responds by pulling RFSH low (M2 and M0) if there are no current DRAM accesses in progress. If a DRAM access is in progress the PAL waits until the current access is completed before performing the forced refresh cycle. If an access is requested during the forced refresh cycle WAIT states are automatically inserted into the access cycle until the refresh cycle is completed and adequate RAS precharge has been completed. The pending DRAM access cycle is then performed. The input signal "NOWAIT" allows one to vary the amount of time required to do a refresh (see the description of the "NOWAIT" input in the pin description section). In one of the timing diagrams the " $\overline{\text{RFSH}}$ " output was tied to the "NOWAIT" input to decrease the length of the refresh cycle but still insert one wait state in normal DRAM access cycles (see Figure 5).

The first PAL (PAL #1) supports memory interleaving to guarantee adequate RAS precharge time during two consecutive accesses to the same DRAM bank. This is performed by looking at the lower address bit or bits, A2 and/or A3. If the processor is sequentially accessing the DRAM each RAS output will have plenty of precharge time. But if the system tries to access the same bank twice in a row the access will be delayed until adequate RAS precharge time has been met. During this time WAIT states will automatically be inserted into the pending access cycle.

The second PAL (PAL #2) guarantees adequate  $\overline{\text{RAS}}$  precharge time (one and one half system clock periods) by ending the DP8418 " $\overline{\text{RASIN}}$ " input early. The DRAM data is held valid by externally latching the DRAM " $\overline{\text{CAS}}$ " input as explained earlier. This has the additional benefit of sim-

### Functional Description (Continued)

plifying the memory interface of the 68020 by eliminating the external components needed for interleaving, though as one approaches 16.7 MHz the interleaving circuitry may again become necessary to guarantee adequate "RAS" precharge time.

For PAL #1 an external "D type" flip-flop or another PAL could be used for the support of memory interleaving. If one is not using memory interleaving (10 MHz or below) the "PREVO" input can be used for some other function and the equations of "RASIN" that employ "PREVO" can be adjusted.

The PAL equations for this interface are written in the National Semiconductor PLANTM format, which differs from the standard PALASMTM format.

EXAMPLE: PLAN FORMAT

### /RASIN := RFSH\*/2D\*/AS

This translates as, "RASIN" is low after the rising edge of the input clock given that "RFSH" was high and "2D" was low and " $\overline{AS}$ " was low a setup time before the clock transitions high (here RASIN, 2D, and RFSH are outputs of the PAL and  $\overline{AS}$  is an input).

EXAMPLE: PALASM FORMAT

### RASIN := /RFSH\*2D\*AS

The above expression means the same as the PLAN format expression except it is written in PALASM format. In other words; "RASIN" will go low after the rising edge of the clock given that "RFSH" was high, "2D" was low, and "AS" was low a setup time before the clock transitions high (here RASIN, 2D, and RFSH are outputs of the PAL and AS is an input).

Depending on the specific type of PALs and logic used the user can calculate the speed requirements for the DRAM at the specified processor frequency as follows:

CALCULATION OF DRAM " $t_{RAC}$ "  $\overline{RAS}$  ACCESS TIME AND " $t_{CAC}$ "  $\overline{CAS}$  ACCESS TIME REQUIRED FOR A 12.5 MHz 68020, 1 WAIT STATE, MICROPROCESSOR SYSTEM

- #1) RASIN generation time = "S0" + "S1" + 1 combinational output delay of the PAL generating the "RASIN" output (assume DMPAL16R4B) = 80 ns + 15 ns = 95 ns maximum
- #2) RASIN to RAS out delay of the DP8418 = 20 ns maximum (used to determine "t<sub>RAC</sub>")
- #3) RASIN to CAS out delay of the DP8418 DRAM contoller driving a load of 2 banks of 256k DRAMs, each bank containing 36 (32 DRAMs plus byte parity) = 72 DRAMs

Since this is under the specified load in the data sheet (approximately 88 DRAMs) approximately 3 ns can be subtracted from the data sheet number, giving 80 ns - 3 ns = 77 ns maximum (used to determine "t<sub>CAC</sub>")

- #4) 74AS244 buffer delay = 7 ns maximum
- #5) Data setup time required from the falling edge of "S4" clock = 10 ns maximum

A normal 12.5 MHz 68020 access cycle (with 1 WAIT state inserted) contains 4 clock periods of 80 ns per period.

The required DRAM "t\_{RAC}" (row access time) can be calculated from

S0 + S1 + S2 + S3 + SW1 + SW2 + S4(minimum 1/2 period) - #1 - #2 - #4 - #5= 40 + 40 + 40 + 40 + 40 + 35- 95 - 20 - 7 - 10 = 143 ns

The required DRAM "t\_CAC" (column access time) can be calculated from

 $\begin{array}{l} \text{S0} + \text{S1} + \text{S2} + \text{S3} + \text{SW1} + \text{SW2} + \text{S4} \\ (\text{minimum 1/2 period}) & - \#1 - \#3 - \#4 - \#5 \\ = 40 + 40 + 40 + 40 + 40 + 40 + 35 \\ - 95 - 77 - 7 - 10 = 86 \text{ ns} \end{array}$ 

The DRAMs selected for this system must satisfy both the "t<sub>RAC</sub> and t<sub>CAC</sub>" requirements. Therefore the DRAMs must have a "t<sub>RAC</sub>" (row access time) less then or equal to 143 ns and a "t<sub>CAC</sub>" (column access time) less than or equal to 86 ns to be used in this system, under worst case conditions, for a 1 WAIT state 12.5 MHz 68020 system. Common 120 ns 64k or 256k DRAMs meet this specification. If one is using PAL #2, producing external "CAS's" and not using any external transceivers he could possibly use 150 ns DRAMs in the above example.

If one is using PAL #2, the calculated "t<sub>RAC</sub>" and "t<sub>CAC</sub>" may differ from the actual system values, depending upon the external circuitry used to produce the byte "CAS's". The DP8418 "RASIN–CAS" low will be approximately 10–15 ns less than the value given in the data sheet because of the small loading on the DP8418 "CAS" output. The external circuitry needed to produce the byte "CAS's" should be loaded such that the column address (from DP8418) is valid when "CAS" goes low. For this reason "RASIN-byte CAS" may be longer than the value used in the "t<sub>RAC</sub>, t<sub>CAC</sub>" calculations, and therefore may give a smaller "t<sub>RAC</sub>, t<sub>CAC</sub>"

### 68020 PAL Inputs and Outputs

(Pin number of the PAL on the left)

PAL #1 Inputs

| 1) ''CK''<br>2) '' <del>AS</del> '' | This is the system clock.<br>Address strobe from 68020.                                                     |
|-------------------------------------|-------------------------------------------------------------------------------------------------------------|
| 3) "RFRQ"                           | This is the refresh request from the DP8418.                                                                |
| 4) '' <del>CS</del> ''              | This is the chip select (see system block diagram).                                                         |
| 5) "R"                              | READ/WRITE output pin from the 68020.                                                                       |
| 6) ''CLK''                          | The system clock.                                                                                           |
| 7) "PREVO"                          | This output holds the previously ac-<br>cessed DRAM "RAS" bank.                                             |
| 8) ''B0''                           | This input is the address bit "A2" and is<br>used to determine which "RAS" bank the<br>system is accessing. |
| 9) '' <u>NOWAIT</u> ''              | This PAL always inserts one WAIT state into every 68020 access cycle. This input,                           |

# 68020 PAL Inputs and Outputs (Continued)

if low, allows the DRAM to be accessed with no wait states inserted into the access cycle. This input also, if low during a refresh, shortens the length of the refresh cycle by one clock period. This causes the RAS pulse width (during a refresh) and the RAS precharge time (after a refresh) to be shorter. This input enables the PAL outputs.

11) "OE" PAL #1 Outputs 19) "XDLY"

19) "XDLY" This signal is used to guarantee one period of "RFSH" high to "RASIN" low time and to guarantee two periods of RAS precharge time in consecutive accesses to the same DRAM bank.

18) "RASIN" This signal causes RAS (or RASs) to go low during a DRAM access or refresh.

17) "RFSH" This signal initiates a DRAM Refresh.

DP84522

16) "TDLY" A delay that is used internally.

15) "2DLY" A delay that is used internally.

14) "RFREQ" Refresh request (from the DP8418) synchronized to the system clock.

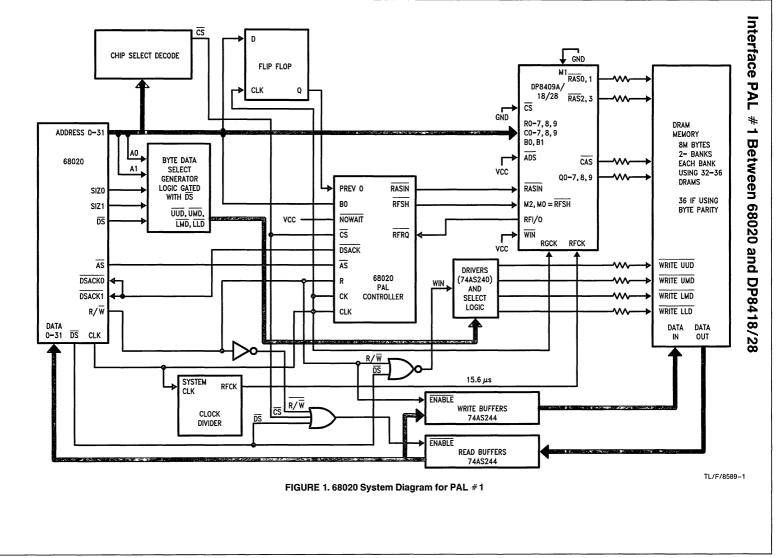
13) "RFREQCK" This input synchronizes "RFREQ" to the falling edge of the input system clock "CLK" and is used in arbitrating between refreshes and accesses (see "RASIN" equations).

12) "DSACK" This output goes to the 68020 "DSACK0, T" data acknowledge input. This output allows WAIT states to be inserted into DRAM access cycles during access/refresh/RAS precharge contention.

## Interface PAL #1 Boolean Equations

This PAL will work up to 16.7 MHz with the 68020. This PAL uses mode 0 (M0 = M1 = M2 = low) for doing externally controlled forced refreshes, guaranteeing more than 2.5 periods of RGCK RAS pulse width ("NOWAIT" = high). If "NOWAIT" is low the refresh is shortened by one clock period. This PAL will only work with the DP8417/18/19/28/29 since it uses mode 0 to reset the RFSH request (RFIO) signal.

| DMPAL16R4A<br>CK AS RFRQ CS R CLK PREVO<br>/OE /DSACK /RFREQCK /RFREQ /2DLY /1                                                                                                                                          | BO /NOWAIT GND<br>DLY /RFSH /RASIN /XDLY VCC                                                                                                 |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|
| <pre>IF (VCC) /XDLY = RFSH*/2DLY*RASIN*PREVO*E<br/>+RFSH*/2DLY*RASIN*/PREVO*/BO<br/>+/RFSH*lDLY*/2DLY*/RASIN*NOWAIT*/CLK<br/>+/RFSH*lDLY*2DLY*RASIN*RFREQ*/NOWAIT<br/>+/XDLY*/RFSH*RFREQ<br/>+/XDLY*RASIN*/AS*CLK</pre> | Same bank interleave ;"/XDLY" low during RFSH                                                                                                |
| <pre>IF (VCC) /RASIN = /RFSH*RFREQ*/lDLY +/RASIN*/RFSH*/2DLY*XDLY +RFSH*RFREQCK*/AS*/CS*PREVO*/B0*CLK +RFSH*RFREQCK*/AS*/CS*/PREVO*B0*CLK +RFSH*RFREQCK*/AS*/CS*2DLY*XDLY*CLK +/RASIN*RFSH*/AS*/CS +/RASIN*/CLK</pre>   | ;RFSH "/RASIN"<br>;Hold "/RASIN" low<br>;Start "/RASIN"<br>;Start "/RASIN"<br>;After idle states<br>;Hold "/RASIN" low<br>;Hold "/RASIN" low |
| IF (VCC) /RFREQCK = /RFREQ*/CLK<br>+/RFREQCK*/RFREQ                                                                                                                                                                     | ;Start from falling clock<br>; edge                                                                                                          |
| <pre>IF (/CS) /DSACK = /CS*RFSH*/RASIN*NOWAIT* +/DSACK*/CS*RFSH*/RASIN*/AS +/CS*RFSH*/AS*/NOWAIT*XDLY</pre>                                                                                                             | '/CLK ;One WAIT state<br>;Hold "/DSACK" low<br>;No WAIT state in access                                                                      |
| /RFSH := /RFREQ*RASIN*/1DLY*/2DLY<br>+/RFREQ*RASIN*1DLY<br>+/RFSH*/RFREQ<br>+/RFSH*/RASIN<br>+/RFSH*/1DLY                                                                                                               | ;Start RFSH<br>;Start RFSH<br>;Hold RFSH low<br>;Hold RFSH low<br>;Hold RFSH low                                                             |
| /1DLY := /RFSH*2DLY*/RFREQ<br>+/RFSH*/1DLY*2DLY*XDLY<br>+RFSH*/RASIN                                                                                                                                                    | ;Start "/lDLY" during RFSH<br>;Continue "/lDLY" during RFSH<br>;Start "/lDLY" during /RASIN                                                  |
| /2DLY := /RFSH*/1DLY<br>+/RFSH*2DLY*/RFREQ*/NOWAIT<br>+RFSH*/RASIN*/1DLY<br>+RFSH*/RASIN*/NOWAIT                                                                                                                        | ;Start "/2DLY" during RFSH<br>;Shorten RFSH<br>;Start "/2DLY" during /RASIN<br>;Shorten access                                               |
| /RFREQ := /RFRQ                                                                                                                                                                                                         | ;Synchronize to system clock                                                                                                                 |



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### Interface PAL #1 Between 68020 and DP8418/28 (Continued)

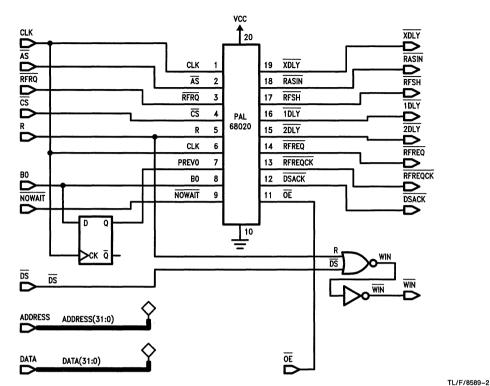
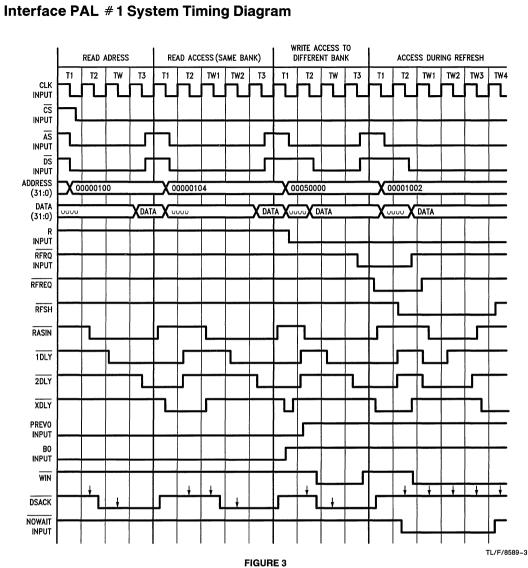
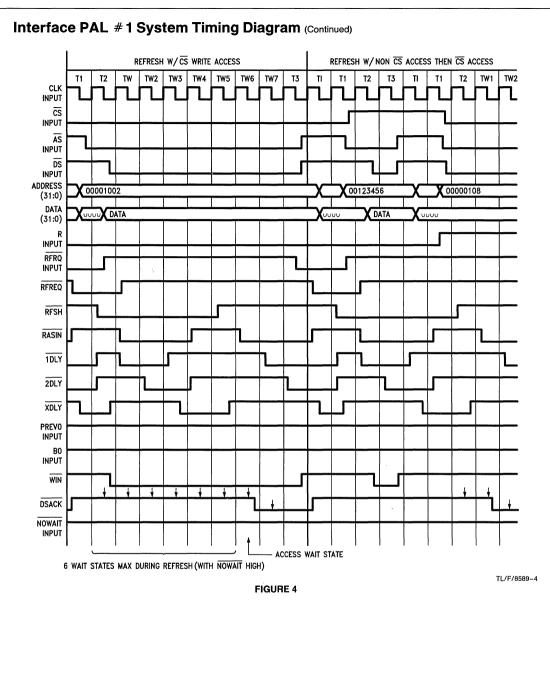


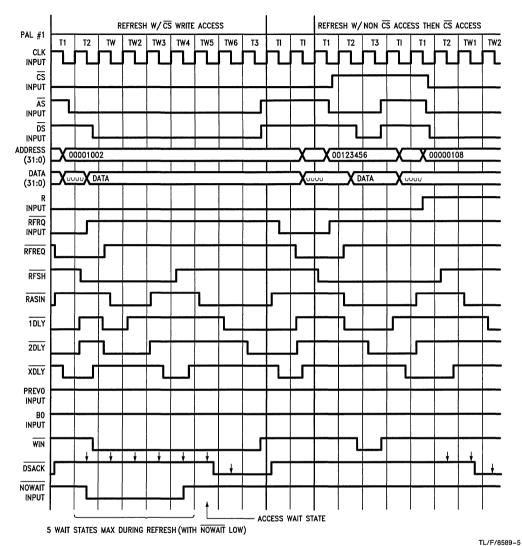
FIGURE 2. PAL # 1 Simulation Diagram

DP84522



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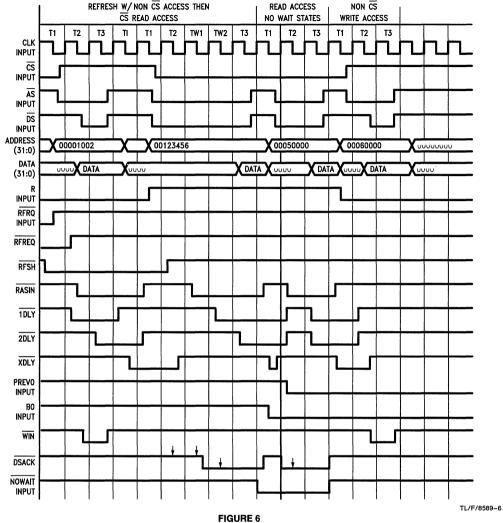
## Interface PAL # 1 System Timing Diagram (Continued)

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FIGURE 5

3

### Interface PAL #1 System Timing Diagram (Continued) REFRESH W/NON CS ACCESS THEN NON CS READ ACCESS CS READ ACCESS NO WAIT STATES WRITE ACCESS T1 TW1 TW2 T1 T2 Т3 TI T2 Т3 T1 T2 T3 T1 T2 T3

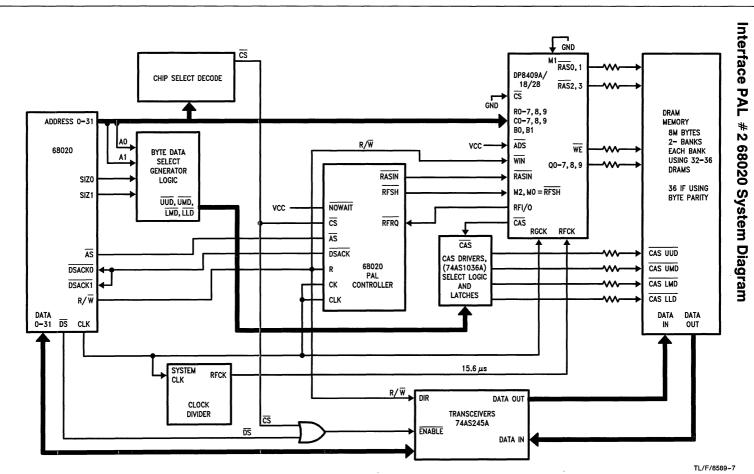


## Interface PAL #2 Boolean Equations

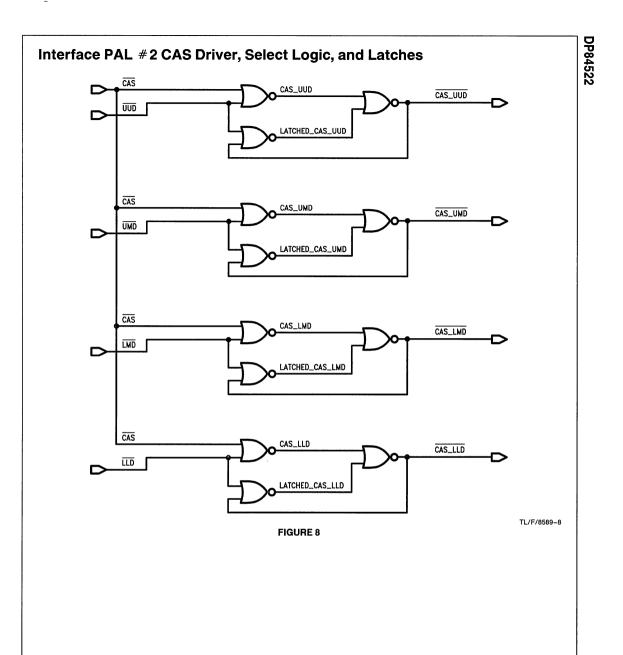
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This PAL is similar to PAL #1 but ends "RASIN" one half period earlier than PAL #1 and relies on the external generation of byte "CAS's" to hold the data valid during 68020 READ access cycles. DMPAL16R4A

| CK /AS /RFRQ /CS R CLK NC1 NC2 /<br>/OE /DSACK /RFREQCK /RFREQ /2DLY /1                                                                                                                             |                                                                                                                                       |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------|
| <pre>IF (VCC) /XDLY = RFSH*/2DLY*/AS +/RFSH*1DLY*/2DLY*/RASIN*NOWAIT*/CLH +/RFSH*1DLY*2DLY*RASIN*RFREQ*/NOWAIT +/RFSH*/XDLY*RFREQ +/XDLY*RASIN*/AS*CLK</pre>                                        |                                                                                                                                       |
| <pre>IF (VCC) /RASIN = /RFSH*RFREQ*/1DLY +/RFSH*/RASIN*/2DLY*XDLY +/RFSH*/RASIN*/CLK +RFSH*RFREQCK*/AS*/CS*XDLY*CLK +RFSH*RFREQCK*/AS*/CS*XDLY*CLK +RFSH*/RASIN*/AS*/CS*XDLY +RFSH*/RASIN*CLK</pre> | ;RFSH "/RASIN"<br>;Hold in RFSH<br>;Hold in RFSH<br>;Start "/RASIN"<br>;After idle states<br>;Hold "/RASIN" low<br>;Hold "/RASIN" low |
| IF (VCC) /RFREQCK = /RFREQ*/CLK<br>+/RFREQCK*/RFREQ                                                                                                                                                 | ;Start from falling clock<br>; edge                                                                                                   |
| <pre>IF (VCC) /DSACK = /CS*RFSH*/RASIN*NOWAIT +/DSACK*/CS*RFSH*/RASIN*/AS +/CS*RFSH*/AS*/NOWAIT*XDLY</pre>                                                                                          | */CLK ;One WAIT state<br>;Hold "/DSACK" low<br>;No WAIT state in access                                                               |
| <pre>/RFSH := /RFREQ*RASIN*/1DLY*/2DLY +/RFREQ*RASIN*1DLY +/RFSH*/RFREQ +/RFSH*/RASIN +/RFSH*/1DLY</pre>                                                                                            | ;Start RFSH<br>;Start RFSH<br>;Hold RFSH low<br>;Hold RFSH low<br>;Hold RFSH low                                                      |
| /1DLY := /RFSH*2DLY*/RFREQ<br>+/RFSH*/1DLY*2DLY*XDLY<br>+RFSH*/RASIN                                                                                                                                | ;Start "/1DLY" during RFSH<br>;Continue "/1DLY" during RFSH<br>;Start "/1DLY" during /RASIN                                           |
| <pre>/2DLY := /RFSH*/1DLY<br/>+/RFSH*2DLY*/RFREQ*/NOWAIT<br/>+RFSH*/RASIN*/1DLY<br/>+RFSH*/RASIN*/NOWAIT</pre>                                                                                      | ;Start "/2DLY" during RFSH<br>;Shorten RFSH<br>;Start "/2DLY" during /RASIN<br>;Shorten access                                        |
| /RFREQ := /RFRQ                                                                                                                                                                                     | ;Synchronize to system clock                                                                                                          |



DP84522



## Interface PAL #2 68020 System Timing Diagram

DP84522

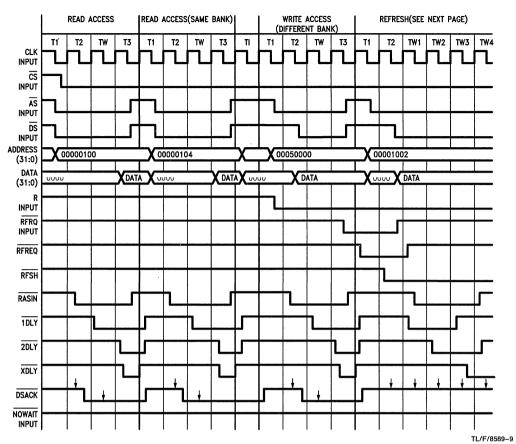
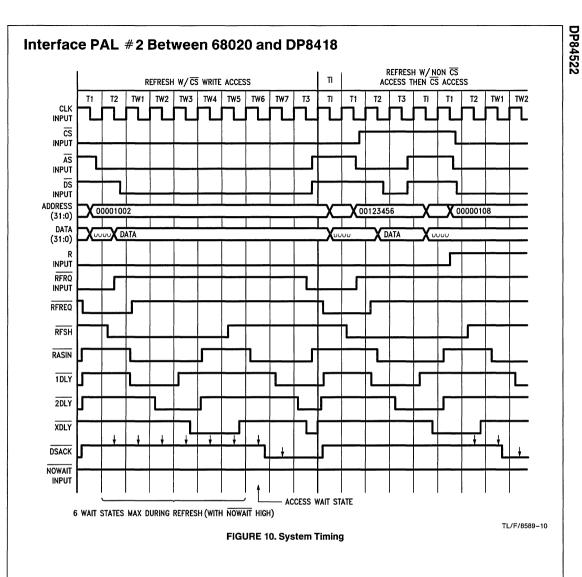
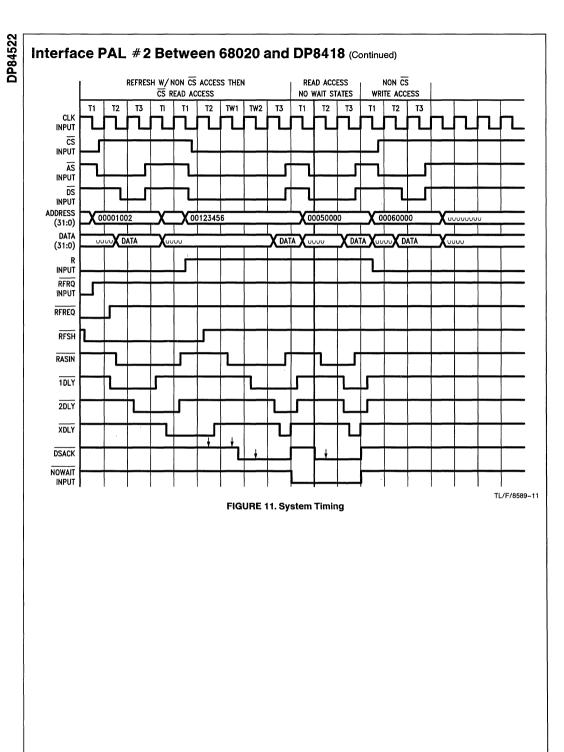


FIGURE 9



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## 3-80

### PRELIMINARY

## DP84532 Dynamic RAM Controller Interface Circuit for the iAPX 286 CPU

## **General Description**

National Semiconductor

This is a Programmable Array Logic (PAL®) device designed to allow an easy interface between the 80286 microprocessor and the National Semiconductor DP8419/29 or DP8409A dynamic memory controllers.

This PAL supplies all the control signals needed to perform memory read, write, and refresh operations up to a frequency of 16 MHz.

## Features

- Provides a 3- or 4-chip solution for the 80286/DP8419 (or DP8409A/29) dynamic RAM interface (1 or 2 PALs, DP8419, and clock divider)
- Works with all speed versions of the 80286 up to 10 MHz
- Allows operation of 80286 at 8 MHz with no WAIT states with standard 120 ns 256k DRAMs
- Controls DP8409A/19 mode 5 accesses and mode 0 or 1 forced refreshes automatically
- Allows memory interleaving if desired
- CPU WAIT states are automatically inserted during contention between memory interleaving/DRAM accesses/ DRAM refreshes
- Uses standard National Semiconductor PALs (i.e., DMPAL16R6A and DMPAL16R4A; the user may want to use faster versions of these PALs at higher CPU operating frequencies)
- The PAL programming equations are provided with comments for easy user modification to his specific requirements

## **Functional Description**

The following description applies to both the DP8409A, DP8419 and DP8429.

A memory cycle starts when chip select ( $\overline{CS}$ ) and the status ( $\overline{S0^*S1}$ ) become true. RASIN is supplied from the PALs to the DP8419 DRAM controller, which then supplies RAS to the selected RAS bank. After the necessary row address hold time, the DP8419 switches the address outputs to the column address. The DP8419 then supplies the required CAS signal to the DRAM. In order to do byte operations a HIGH WRITE ENABLE and a LOW WRITE ENABLE are produced from PAL #2. All WRITE cycles are LATE WRITE cycles, to assure that valid data is written to the DRAMs. A WRITE strobe is produced by PAL #1 to assure enough WIN pulse width and to guarantee that valid data is latched into the DRAMs when writing to them. Memory buffers are used externally, to separate the data in from the data out of the DRAMs during LATE WRITE cycles.

Hidden REFRESH cycles are not allowed in this set of PALs because of the need for adequate RAS precharge times in all circumstances and the desire not to be inserting WAIT states into access cycles of other system elements.

These PALs perform automatic or externally controlled forced refreshes (mode 0 or 1). A refresh cycle occurs when the DP8419 input RFCK transitions low and the RFIO signal goes low requesting a refresh cycle. The PAL responds by pulling  $\overline{\text{RFSH}}$  (M2, and/or MO depending on whether mode 1 or 0 is desired) low if there are no current DRAM accesses in progress. If a DRAM access is in progress the PAL waits until the current access is completed before performing the forced refresh cycle. If an access is requested during the forced refresh cycle WAIT states are automatically inserted into the access cycle until the refresh cycle is completed and adequate  $\overline{\text{RAS}}$  precharge has been completed. The pending DRAM access cycle is then performed.

In order to guarantee adequate  $\overline{\text{RAS}}$  precharge time during two consecutive accesses to the same DRAM bank, memory interleaving is performed by looking at the two lower address bits, A1 and A2. If the processor is sequentially accessing the DRAM, each  $\overline{\text{RAS}}$  output will have plenty of precharge time. But if the system tries to access the same bank twice in a row the access will be delayed until adequate  $\overline{\text{RAS}}$  precharge time has been met. During this time WAIT states will automatically be inserted into the pending access cycle.

The 8 MHz 80286 has two "T" states ("Ts" and "Tc"), it is possible for these PALs to get one clock phase out of sync with the 80286 CPU during access cycles pending while performing a refresh cycle. The two 8 MHz "T" states of the CPU contain four 16 MHz clock periods ("CLK" output of 82284 clock generator). This 2X clock is the clock the interface described herein uses. In other words, the PALs produce a RASIN output that is low for three 16 MHz clock periods for the 8 MHz 80286. Since WAIT states insert two 16 MHz clock periods and RASIN can start one clock period after RFSH transitions high, it is possible for RASIN to start one period early and go high one period before the access cycle ends, thus not holding the data valid during a READ access cycle long enough. To counteract this problem the term "ALE" is used in several of the PAL equations (RASIN, 1DLY, and 2DLY) to sync the RASIN output to the access cycle. See the timing diagrams (Figure 6) and PAL equations for some further insight into the potential problems. This synchronization could also have been done externally by holding CAS low until either MWTC or MRDC go high, thus holding the READ data valid until the access cycle is over.

Two PALs were designed for this PAL interface. PAL #2 is used mostly for the support of memory interleaving. If one is not using memory interleaving (6 MHz or below) PAL #2 can be omitted and the PAL #1 "PRECH" input can be tied high. The high and low memory write strobes can be produced externally.

#### Functional Description (Continued)

The PAL equations for this interface are written in the National Semiconductor PLANTM format, which differs from the standard PALASMTM format.

#### EXAMPLE: PLAN FORMAT

#### /RASIN := RFSH\*/2D\*ALE

This translates as, " $\overline{\text{RASIN}}$ " is low after the rising edge of the input clock given that " $\overline{\text{RFSH}}$ " was high and " $\overline{2D}$ " was low and "ALE" was high a setup time before the clock transitions high (here  $\overline{\text{RASIN}}$ ,  $\overline{2D}$ , and  $\overline{\text{RFSH}}$  are outputs of the PAL and ALE is an input).

#### EXAMPLE: PALASM FORMAT

#### RASIN := /RFSH\*2D\*ALE

The above expression means the same as the PLAN format expression except it is written in PALASM format. In other words, "RASIN" will go low after the rising edge of the clock given that "RFSH" was high, "2D" was low, and "ALE" was high a setup time before the clock transitions high (here RASIN, 2D, and RFSH are outputs of the PAL and ALE is an input).

Depending on the specific type of PALs and logic used, the user can calculate the speed requirements for the DRAM at the specified processor frequency as follows:

CALCULATION OF DRAM " $t_{RAC}$ "  $\overline{\text{RAS}}$  access time and " $t_{CAC}$ "  $\overline{\text{CAS}}$  access time required for an 8 MHz 80286, NO wait state, Microprocessor system

- # 1) RASIN generation time = one period of the system clock + one 74AS244 gate delay (the system clock is inverted to the PALs) + one clocked output delay of the PAL generating the RASIN output (assume DMPAL16R6B) = 62.5 ns + 4.5 ns + 12 ns = 79 ns maximum
- #2) RASIN to RAS out delay of the DP8419 = 20 ns maximum (used to determine "t<sub>RAC</sub>")
- #3) RASIN to CAS out delay of the DP8419 DRAM controller driving a load of 4 banks of 256k DRAMs, each bank containing 18 (16 DRAMs plus byte parity) = 72 DRAMs

Since this is under the specified load in the data sheet (approximately 88 DRAMs) approximately 3 ns can be subtracted from the data sheet number, giving 80 ns - 3 ns = 77 ns maximum (used to determine "t<sub>CAC</sub>").

- #4) 74AS244 buffer delay = 7 ns maximum
- #5) Data setup time required from the end of " $T_C$ " phase 2 clock cycle = 10 ns minimum

A normal 8 MHz 80286 access cycle contains 4 clock periods (16 MHz) of 62.5 ns per period = 250 ns

The required DRAM "t<sub>RAC</sub>" (row access time) can be calculated from 250 ns - #1 - #2 - #4 - #5 = 134 ns

The required DRAM "t<sub>CAC</sub>" (column access time) can be calculated from 250 ns - #1 - #3 - #4 - #5 = 77 ns. The DRAMs selected for this system must satisfy both the "t<sub>RAC</sub>" and "t<sub>CAC</sub>" requirements. Therefore the DRAMs must have a "t<sub>RAC</sub>" (row access time) less than or equal to 134 ns and a "t<sub>CAC</sub>" (column access time) less than or equal to 77 ns to be used in this system, under worst case conditions, for a no WAIT state, 8 MHz 80286 system. Common 120 ns 256k DRAMs meet this specification.

### **Other Options**

In the system block diagram, buffers (74AS244s) were used to isolate the data in from the data out of the DRAM. This is needed because all WRITE accesses are late WRITEs (READ-MODIFY-WRITE cycles). In this system a HIGH and LOW WRITE enable were produced. The user could just as well have produced a HIGH and LOW CAS. In producing a HIGH and LOW CAS, the user would need the WRITE output of PAL #1 (to bring CAS low during a WRITE), A0 and BHE (for byte WRITEs), and the DT/R signal (for determining whether the access is a READ or WRITE access). Also, by generating a HIGH and LOW CAS, the system can use transceivers instead of buffers in the DRAM data path. The only problem with this approach is that RASIN to CAS out may take a little longer since  $\overline{CAS}$  goes through some external logic.

## 80286 PAL Inputs and Outputs

(Pin number of the PAL on the left)

#### PAL #1 INPUTS

| 1) " <u>CLK</u> "    | This is the inverted system clock ("CLK") of the 82284 clock generator. |
|----------------------|-------------------------------------------------------------------------|
| 2) " <del>CS</del> " | This is the latched chip select (see system block diagram).             |
| 3) "RFRQ"            | Refresh request from the DP8419.                                        |

- 4) "So" Status pin from the 80286.
- 5) "Status pin from the 80286.
- 6) "ALE" Address latch enable from 82288.
- 7) "NC1" No contact.
- 8) "PRECH" This signal indicates that a back-to-back access cycle, to the same DRAM bank, is taking place. In this situation, the PAL controller will delay "RASIN" until adequate RAS precharge time has been guaranteed, and also insert WAIT states into the present access cycle to accommodate the extra precharge time.
- 9) "NC2" No contact.
- 11) "OE" This input enables the PAL outputs.

#### PAL #1 OUTPUTS

- 19) "CYREQ" This signal indicates that an access was requested during a Refresh or during the precharge time of the previous access.
- 18) "RFREQ" This output guarantees that the refresh request occurs within 15 ns after the system clock. This is necessary in order for the refresh/access arbitration to work correctly.
- 17) "RASIN" This signal causes RAS (or RASs) to go low during a DRAM access or refresh.
- 16) "RFSH" This signal initiates a DRAM Refresh.
- 15) "TDLY" A delay that is used internally.
- 14) "2DLY" A delay that is used internally.
- 13) "SYNRDY" This output goes to the 82284 clock generator synchronous ready input. This output inserts WAIT states into DRAM access cycles during access/refresh/RAS precharge contention.
- 12) "WRITE" This output produces a WRITE strobe for the DRAMs.

#### PAL #2 INPUTS

- 1) "ALE" This is the address latch enable input from the 82288.
- 2) "B0" This is the "A1" address bit from the 80286.
- 3) "B1" This is the "A2" address bit from the 80286.
- 4) "RASIN" This signal causes RAS (or RASs) to go low during a DRAM access or refresh.
- 5) "1DLY" This is a delay used internal to the PALs.)
- 6) "RFSH" This signal initiates a DRAM Refresh.
- 7) "WRITE" This output produces a WRITE strobe for the DRAMs.
- 8) "A0" This is the "A0" address bit from the 80286 and is used during byte read or byte write situations.
- 9) "BHE" This is the high byte enable signal from the 80286 and is used during byte read or byte write situations.
- 11) "OE" This input enables the PAL outputs.

#### PAL #2 OUTPUTS

- 19) "PRECH" This signal indicates that a back-to-back access cycle, to the same DRAM bank, is taking place. In this situation, the PAL controller will delay "RASIN" until adequate RAS precharge time has been guaranteed, and also insert WAIT states into the present access cycle to accommodate the extra precharge time.
- 18) "NC" No contact to this pin.
- 17) "PREV0" Latches if the previous access was to Bank 0.
- 16) "PREV1" Latches if the previous access was to Bank 1.
- 15) "PREV2" Latches if the previous access was to Bank 2.
- 14) "PREV3" Latches if the previous access was to Bank 3.
- 13) "WINLOW" This is the low byte DRAM write input.
- 12) "WINHIGH" This is the high byte DRAM write input.

# DP84532

## Equations for PALs to Interface the DP8419 to the 80286

These PALs work up to 10 MHz and use mode 0 for doing externally controlled forced refreshes, guaranteeing 3 periods (of 2X clock from 82284) of RGCK RAS pulse width. This set of PALs will only work for the DP8419 since they use mode 0 forced refresh to reset the refresh request (RFIO) signal.

```
PAL #1
DMPAL16R6A
/CLK /CS /RFRQ /SO /S1 ALE NC1 /PRECH NC2
                                                    GND
/OE /WRITE /SYNRDY /2DLY /1DLY /RFSH /RASIN /RFREQ /CYREQ VCC
IF (VCC) /CYREQ = /CS*/RFSH*SO*/S1
                                                    ;Read access during RFSH
           +/CS*/RFSH*/S0*S1
                                                    ;Write access during RFSH
           +/CYREQ*/RFSH
                                                    :Hold "/CYREQ" during RFSH
           +/CYREQ*RASIN
                                                    ;Hold "/CYREQ"
           +/CYREQ*1DLY
                                                    :Hold "/CYREQ"
           +/CS*RASIN*1DLY*/2DLY*S0*/S1
                                                    ;Precharge needed during access
           +/CS*RASIN*1DLY*/2DLY*/SO*S1
                                                    ;Precharge needed during access
IF (VCC) /WRITE = /SO*S1*/CS*ALE
                                                    :Write access
           +/WRITE*1DLY
                                                    :Hold "/WRITE" low
           +/WRITE*/RFSH
                                                    ;Hold "/WRITE" low
           +/WRITE*/RASIN
                                                    ;Hold "/WRITE" low
/RFREQ := /RFRQ
/RASIN := /RFSH*/1DLY*/ALE
                                                    ;RFSH "/RASIN" except if "ALE"
  +/RFSH*/1DLY*/RASIN
                                                    ;Keep "/RASIN" low during RFSH
  +RFSH*/SO*S1*PRECH*RFREQ*/ALE*/CS
                                                    :WRITE access
  +RFSH*SO*/S1*PRECH*RFREQ*/ALE*/CS
                                                    :READ access
  +/RASIN*RFSH*2DLY
                                                    ;Hold "/RASIN" low
  +RFSH*/CYREQ*1DLY*2DLY*/ALE
                                                    ;"/RASIN" after precharge delay
                                                    : or RFSH
/RFSH := /RFREQ*RASIN*1DLY*/2DLY
                                                    :Start RFSH after access
  +/RFREQ*RASIN*/1DLY*/2DLY
                                                    ;Start RFSH after access
  +/RFREQ*RASIN*1DLY*2DLY*CYREQ
                                                    :Start RFSH after idle states
  +/RFSH*/1DLY
                                                    ;Hold RFSH low
  +/RFSH*/2DLY
                                                    :Hold RFSH low
  +/RFSH*/RFREQ
                                                    :Hold RFSH low
/1DLY := /RFSH*2DLY*/RFREQ
                                                    ;"/1DLY" during RFSH
  +/RFSH*/RASIN*2DLY*/1DLY
                                                    :Hold "/IDLY" low
                                                    ;Hold "/IDLY" low if "ALE"
  +/RFSH*/RASIN*/1DLY*ALE
  +RFSH*/RASIN
                                                    "/IDLY" during access
/2DLY := /RFSH*/RASIN
                                                    :"/2DLY" during RFSH
  +/RFSH*/2DLY*ALE
                                                    ;Hold "/2DLY" low if "ALE"
  +RFSH*/RASIN*/1DLY
                                                    ;"/2DLY" during access
  +RFSH*/1DLY*/2DLY*/PRECH*RASIN*RFREQ
                                                    ;Hold "/2DLY" low for precharge
/SYNRDY := /CS*/RASIN*1DLY*RFSH
                                                    ;"/SYNRDY" during an access
```

Equations for PALs to Interface the DP8419 to the 80286 (Continued) PAL #2 DMPAL16R4A ALE BO B1 /RASIN /IDLY /RFSH /WRITE AO /BHE GND /OE /WINHIGH /WINLOW /PREV3 /PREV2 /PREV1 /PREVO NC /PRECH VCC IF (VCC) /PRECH = RFSH\*/BO\*/B1\*/PREVO\*RASIN\*/IDLY :Need precharge during +RFSH\*BO\*/B1\*/PREV1\*RASIN\*/1DLY ; present access if +RFSH\*/BO\*B1\*/PREV2\*RASIN\*/1DLY ; previous access bank = +RFSH\*BO\*B1\*/PREV3\*RASIN\*/1DLY ; present access bank /PREVO := /BO\*/B1 :Previous access to bank O /PREV1 := B0\*/B1 :Previous access to bank 1 /PREV2 := /BO\*B1 Previous access to bank 2 /PREV3 := B0\*B1 Previous access to bank 3 IF (VCC) /WINLOW = RFSH\*/RASIN\*/1DLY\*/AO\*/WRITE ;"/WRITE" during access IF (VCC) /WINHIGH = RFSH\*/RASIN\*/1DLY\*/BHE\*/WRITE ;"/WRITE" during access

## Equations for PALs to Interface the DP8409A or DP8419 to the 80286

These PALs work up to 10 MHz with the DP8419 and up to a frequency where the minimum RGCK high or low pulse width (of 82284 2X clock) is equal to or greater than 35 ns for the DP8409A. These PALs only guarantee 2 system clock periods of RAS low during refresh and 2 periods of RAS precharge time (of 82284 2X clock) between consecutive accesses to the same RAS bank.

PAL #1

```
DMPAL16R6A
/CLK /CS /RFRQ /SO /S1 ALE NC1 /PRECH NC2 GND
/OE /WRITE /SYNRDY /2DLY /1DLY /RFSH /RASIN /RFREQ /CYREQ VCC
IF (VCC) /CYREQ = /CS^*/RFSH^*SO^*/S1
                                           :Read access during RFSH
           +/CS*/RFSH*/SO*S1
                                           ;Write access during RFSH
           +/CYREQ*/RFSH
                                           ;Hold "/CYREQ" during RFSH
           +/CYREQ*RASIN
                                           ;Hold "/CYREQ"
           +/CYREQ*1DLY
                                           ;Hold "/CYREQ"
           +/CS*RASIN*1DLY*/2DLY*SO*/S1
                                           ;Precharge needed during access
           +/CS*RASIN*1DLY*/2DLY*/SO*S1
                                           ;Precharge needed during access
IF (VCC) /WRITE = /SO*S1*/CS*ALE
                                           ;Write access
                                           ;Hold "/WRITE" low
           +/WRITE*1DLY
           +/WRITE*/RFSH
                                           ;Hold "/WRITE" low
           +/WRITE*/RASIN
                                           ;Hold "/WRITE" low
/RFREQ := /RFRQ
/RASIN := RFSH*/S0*S1*PRECH*RFREQ*/ALE*/CS
                                               ;WRITE access
     +RFSH*SO*/S1*PRECH*RFREQ*/ALE*/CS
                                               ;READ access
     +/RASIN*RFSH*2DLY
                                               :Hold "/RASIN" low
     +RFSH*/CYREQ*1DLY*2DLY*/ALE
                                               ;"/RASIN" after precharge
                                               ; delay or RFSH
   /RFSH := /RFREQ*RASIN*1DLY*/2DLY
                                              ;Start RFSH after access
        +/RFREQ*RASIN*/1DLY*/2DLY
                                              ;Start RFSH after access
        +/RFREQ*RASIN*1DLY*2DLY*CYREQ
                                              :Start RFSH after idle states
        +/RFSH*/1DLY
                                              ;Hold RFSH low
        +/RFSH*/2DLY
                                              ;Hold RFSH low
        +/RFSH*/RFRQ
                                              ;Hold RFSH low
```

3

## Equations for PALs to Interface the DP8409A or DP8419 to the 80286 (Continued)

| /ldly := /RFSH*2dLy*/RFRQ            | ;"/lDLY" during RFSH            |
|--------------------------------------|---------------------------------|
| +/RFSH*/1DLY*2DLY                    | ;Hold "/1DLY" low               |
| +RFSH*/RASIN                         | ;"/lDLY" during access          |
| /2DLY := /RFSH*/1DLY*/ALE            | ;"/2DLY" during RFSH            |
| +/RFSH*/2DLY*ALE                     | ;Hold "/2DLY" low if "ALE"      |
| +RFSH*/RASIN*/1DLY                   | ;"/2DLY" during access          |
| +RFSH*/1DLY*/2DLY*/PRECH*RASIN*RFREQ | ;Hold "/2DLY" low for precharge |

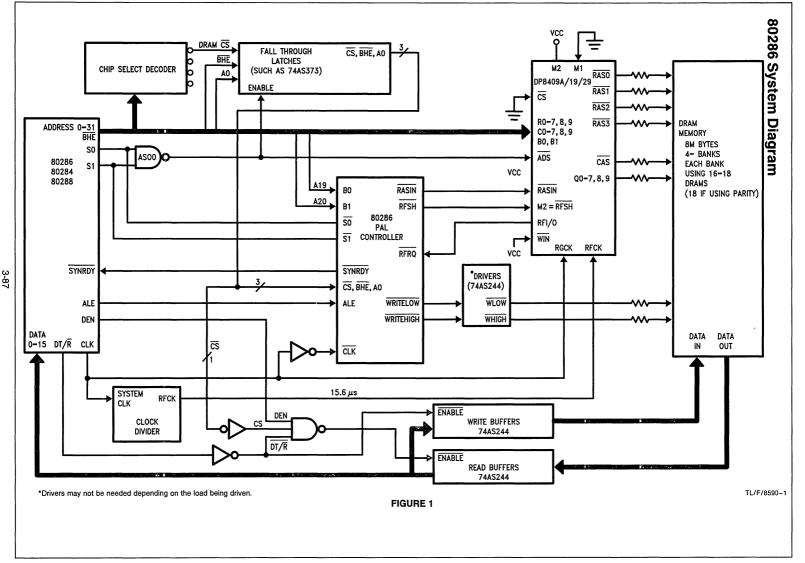
/SYNRDY := /CS\*/RASIN\*1DLY\*RFSH

DP84532

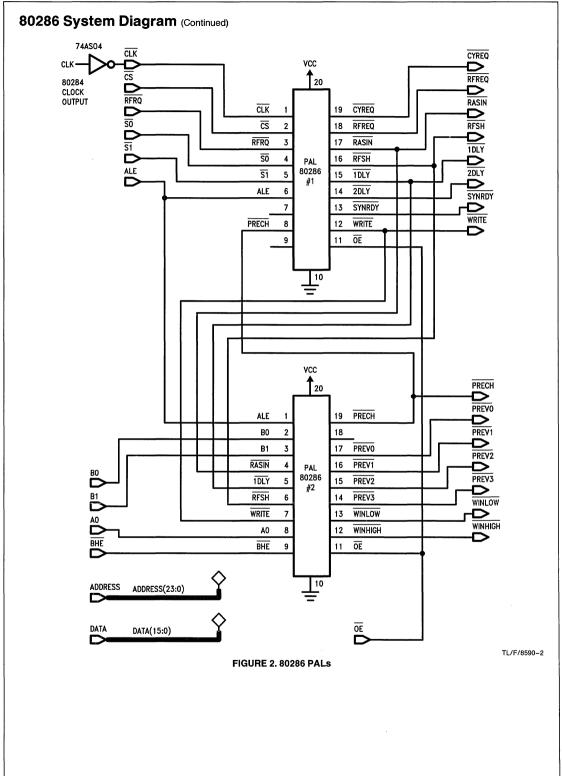
;"/SYNRDY" during an access

If only 2 banks of DRAM were to be used the PAL interface would require only 1 PAL. The two inputs "PRECHOUT and NC" (pin #8 and #9) could be changed to "B0" and "PREVB0" to allow interleaving of bank 0 and 1. "PREVB0" could be produced externally using a "D" type flip-flop with "ALE" as its clock and "B0" as its input. The equations for "RASIN" and "2DLY" will have to be changed as follows:

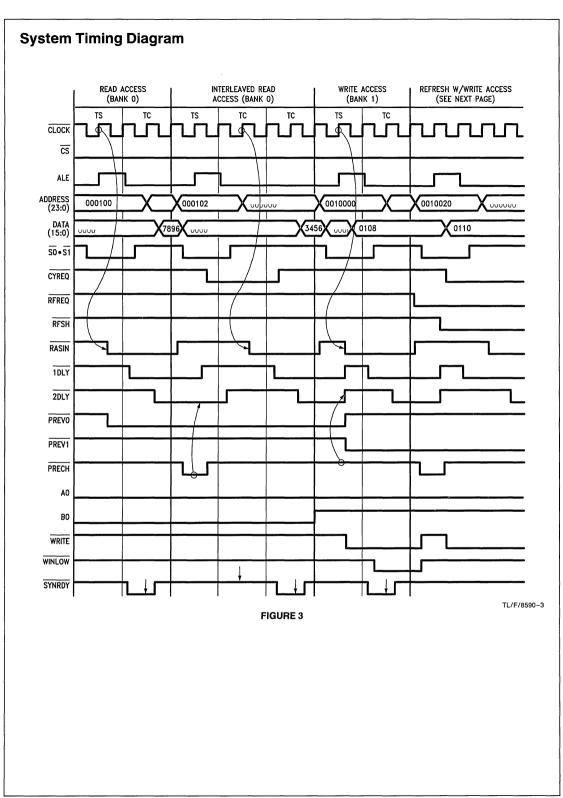
| /RASIN := /RFSH*/1DLY*/ALE                | ;RFSH "/RASIN"                  |
|-------------------------------------------|---------------------------------|
| +/RFSH*/1DLY*/RASIN                       | Hold "/RASIN" low in RFSH       |
| +RFSH*/SO*S1*BO*/PREVBO*RFREQ*/ALE*/CS    | ;WRITE access                   |
| +RFSH*/SO*S1*/BO*PREVBO*RFREQ*/ALE*/CS    | ;WRITE access                   |
| +RFSH*SO*/S1*BO*/PREVBO*RFREQ*/ALE*/CS    | ;READ access                    |
| +RFSH*SO*/S1*/BO*PREVBO*RFREQ*/ALE*/CS    | ;READ access                    |
| +/RASIN*RFSH*2DLY                         | Hold ""/RASIN'' low             |
| +RFSH*/CYREQ*1DLY*2DLY*/ALE               | ;"/RASIN" after precharge       |
|                                           | ; delay or RFSH                 |
| /2DLY := /RFSH*/1DLY                      | ;"/2DLY" during RFSH            |
| +/RFSH*/2DLY*ALE                          | Hold "/2DLY" low if "ALE"       |
| +RFSH*/RASIN*/1DLY                        | ;"/2DLY" during access          |
| +RFSH*/1DLY*/2DLY*/B0*/PREVB0*RASIN*RFREQ | ;Hold "/2DLY" low for precharge |



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DP84532

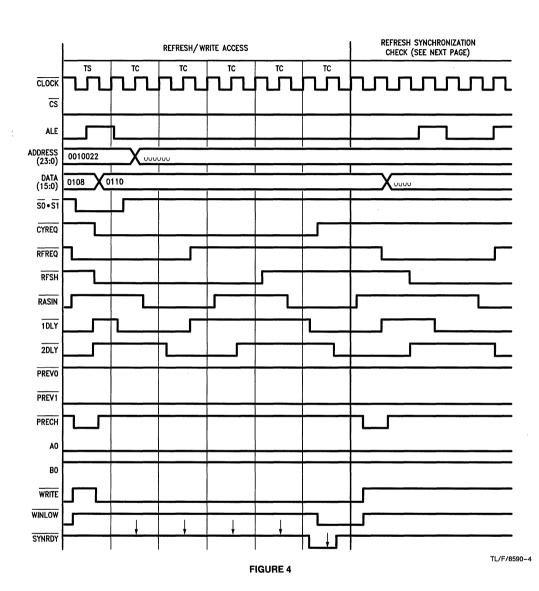


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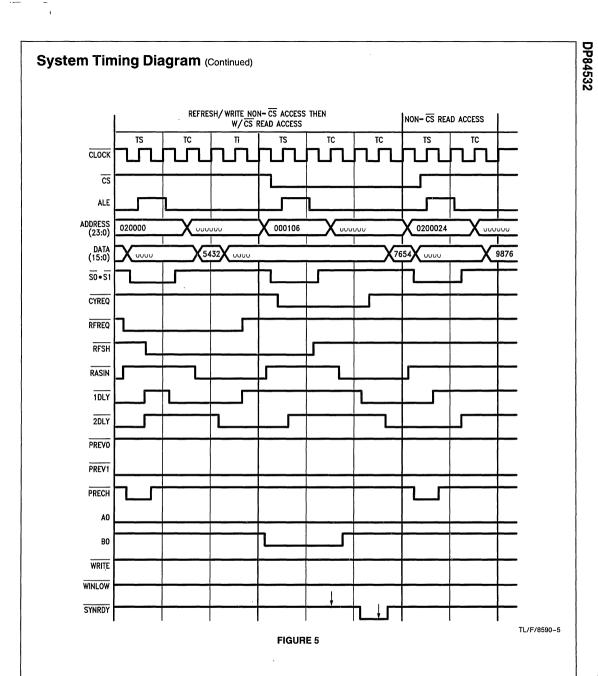
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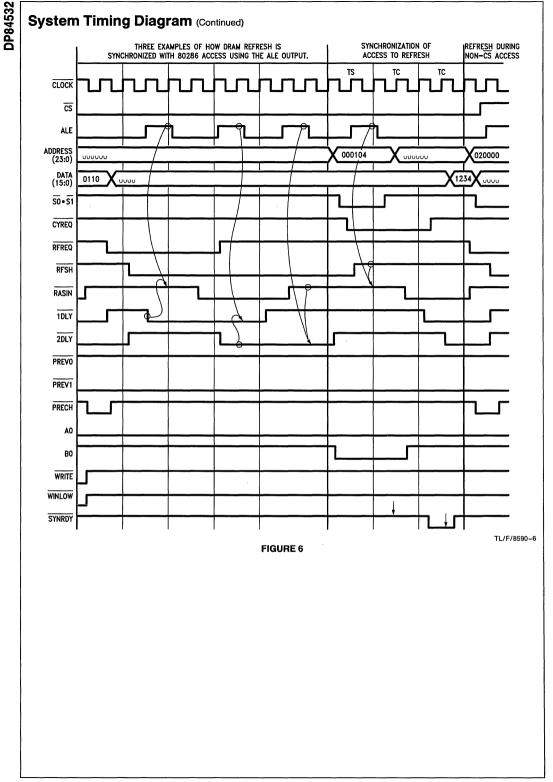
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## System Timing Diagram (Continued)



DP84532





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## Interfacing the DP8408A/09A To Various Microprocessors

High storage density and low cost have made dynamic RAMs the designer's choice in most memory applications. However, the major drawback of dynamic RAMs is the complex timing involved. First, a RAS must occur with the row address previously set up on the multiplexed address bus. After the row address has been held for some minimum time after RAS (namely the row address hold time of the dynamic RAMs, t<sub>RAH</sub>), the column address is set up and then CAS occurs. In addition, refreshing must be done periodically to keep all memory cells charged.

With the introduction of the DP8408A Dynamic RAM Controller/Driver, the above complexities are simplified. The DP8408A is housed in a 48-pin package with eight multiplexed address outputs (Q0-7) and six control outputs (RAS0-3, CAS, WE). It consists of two 8-bit address latches and an 8-bit refresh counter. All the output drivers are capable of driving 500 pF loads.

The following discussion demonstrates a typical application of the DP8408A Dynamic RAM Controller/Driver in Z8000TM- and Z80®-based systems. The DP8408A basically has six modes of operation: Externally Controlled Refresh, Externally Controlled All-RAS Write, Externally Controlled Access, Auto Access (slow t<sub>RAH</sub>), Auto Access (fast t<sub>RAH</sub>) and Set End of Count.

The DP8408A, operating in the auto access mode, requires only **FASIN** to initiate a memory access cycle because all the dynamic RAM's control signals are automatically delayed from this input. (Refer to *Figure 1* for the auto access timing sequence.)

In the following applications, the DP8408A operates in either mode 5 or mode 6 Auto Access and mode 1 or 2 Externally Controlled Refresh to provide minimum additional logic.

## The DP8408A and Z8000 Interface

#### MEMORY ACCESS CYCLE

Figure 2a shows the detailed block diagram of Z8000 and the DP8408A interface. Consider a memory cycle of the Z8000; first, the memory address is output on the Address and Data multiplexed bus (AD0–15) during T1 and is latched to the DP8408A by  $\overline{AS}$ . Simultaneously,  $\overline{MREQ}$  goes low and is used to provide  $\overline{RASIN}$  to initiate a memory transaction cycle. Then the selected  $\overline{RAS}$  output, row address hold time (t<sub>RAH</sub>), column address set up time (t<sub>ASC</sub>) and  $\overline{CAS}$  output will follow  $\overline{RASIN}$  as determined by the auto access modes. A maximum of one wait state is required for 6 MHz and 10 MHz CPUs. This wait state is automatically inserted by the  $\overline{CAS}$  output of the DP8408A. For systems using byte-writing, the DM74S158 provides two separate  $\overline{CAS}$  outputs for accessing the low and high byte of memo-

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ry. Note that  $\overline{\text{DS}}$  from the Z8000 is also gated with the DP8408A's CAS output to generate CASL and CASH. This guarantees the valid data from the Z8000 being written into memory during memory write cycles. Refer to *Figure 3* for the detailed memory transaction cycle timing.

The following formula allows the designer to determine the proper memory speed in terms of  $t_{CAC}$  (access time from CAS):

$$\label{eq:tcac} \begin{split} t_{CAC} \, \text{max.} = & 3 \times t_{cC} - \text{tdc}(\text{MR}) - t_{\text{RICL}} - t_{CASdly} - \\ & t_{\text{sDR}}(\text{C}) \, - \, 15. \end{split}$$

The Z8000 parameters:

t<sub>cC</sub>: clock cycle time

 $t_{sDB}(C)$ : read data to clock  $\downarrow$  set up time

tdc(MR): clock to MREQ delay

The DP8408A, 74S158 and 74LS245 parameters: t<sub>BICL</sub>: RASIN to CAS delay

t<sub>CASdly</sub>: the propagation delay of the 74S158

15 ns: the propagation delay of the 74LS245 (at 50 pF load)

For the 10 MHz CPU and the DP8408A:

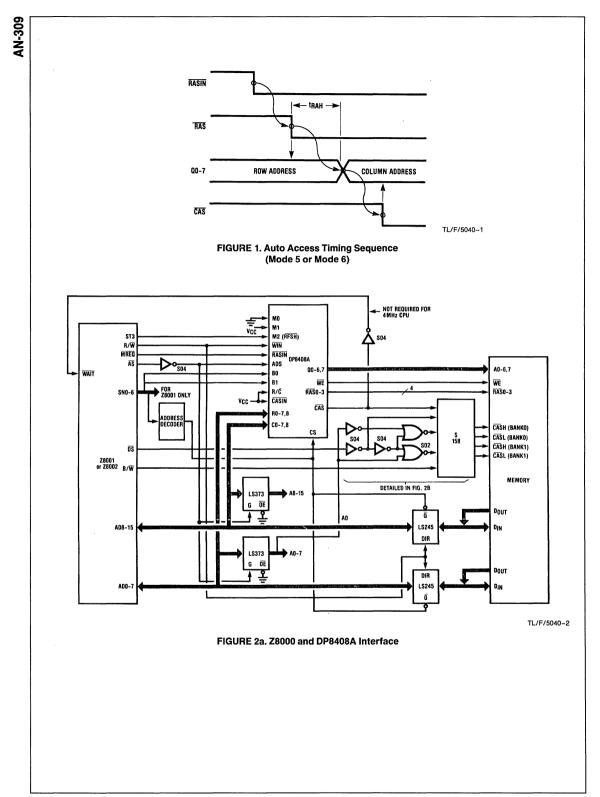
 $t_{CAC}$  max. = 300 - 40 - 131 - 14 - 10 - 15 = 90 ns.

- $t_{RICL}$  max. (mode 6) = 131 ns at 15 pF load.
- t<sub>CASdly</sub> max. = 14 ns at 50 pF load.

Since  $\overline{\text{MREQ}}$  is connected directly to  $\overline{\text{RASIN}}$ , t<sub>RP</sub> (RAS precharge time) and t<sub>RAS</sub> (RAS pulse width) are determined by MREQ high and low, respectively.

#### MEMORY REFRESH CYCLE

The Z8000 CPU contains a refresh rate counter for automatic memory refresh. This counter should be programmed during the processor initialization to determine the refresh rate. Since memory refresh is automatically inserted by the Z8000, there is no additional refresh arbitration logic allowed. The CPU's STATUS 3 (ST3) output can be directly connected to the M2 (RFSH) pin of the DP8408A. During the memory refresh cycle, ST3 goes low, setting the DP8408A in the external control refresh mode (mode 2). Then all four RAS outputs will follow MREQ to strobe the DP8408A's refresh address to all memory banks (the Z8000 refresh address is ignored). As MREQ goes high again, the DP8408A increments its refresh counter, preparing it for the next refresh cycle. Refer to Figure 4 for the refresh cycle timing. Note that ST3 also goes low during the internal cycle, I/O reference cycle and interrupt acknowledge cycle, but the memory will not be refreshed because MREQ is not active during these cycles. The DP8408A on-chip refresh counter will not be incremented when M2 goes low unless MREQ is inserted.



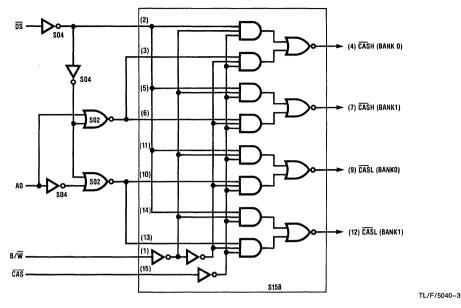


FIGURE 2b. CASH and CASL Decoder

When the processor is in either halt state (by executing the privileged HALT instruction) or single-stepping mode (when STOP) input is low), it introduces memory refresh cycles. However, care should be taken when the CPU is in either a WAIT state or a Bus Acknowledge cycle, that the dynamic RAM refresh will not take place. If these conditions occur over a long period of time, a burst refresh is recommended. This can be done by toggling RASIN while keeping M2 low, until all the rows of the dynamic RAM have been refreshed, then the CPU can resume its operations.

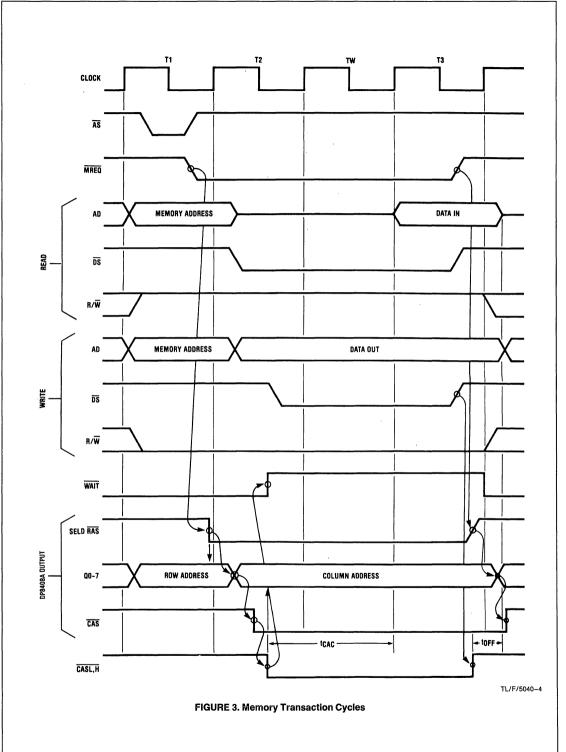
## The DP8408A and Z80A® Interface

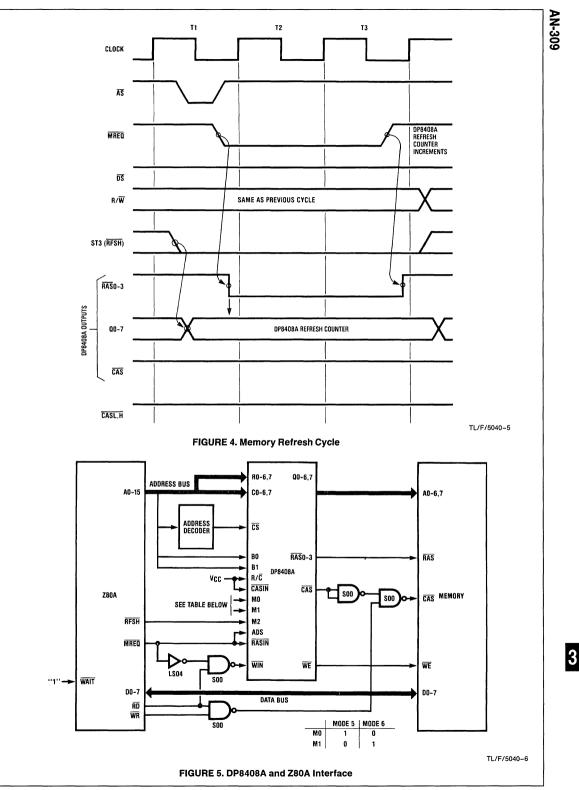
#### INSTRUCTION FETCH CYCLE

*Figure 5* shows the detailed interconnections between the DP8408A, the Z80 and the Dynamic RAMs. *Figure 6* shows the timing during an M1 cycle (op code fetch). The program counter is output on the address bus at the beginning of the M1 cycle. One-half clock later  $\overline{MREQ}$  goes active. This input is used to provide  $\overline{RASIN}$  to the DP8408A to access the dynamic memory. Subsequently, the selected  $\overline{RAS}$  output,

Row to Column Select and then CAS output will automatically follow RASIN as determined by the Auto Access modes of the DP8408A. The RD line also goes active to indicate a memory read cycle is in progress. After t<sub>CAC</sub> (access time from CAS), read data becomes valid. This data is sampled on the rising edge of T3, then both MREQ and RD go inactive. Immediately following this, RFSH goes low, putting the DP8408A in the Externally Controlled Refresh mode. The MREQ goes active causing all four RAS outputs to go active to perform a refresh to all the banks of the dynamic RAMs. Note that during memory refresh cycles, the refresh address from the CPU is output on the address bus. However, the contents of the DP8408A on-chip refresh counter are used instead to provide the row address to the dynamic memory array. Since the Z80 provides only a 7-bit refresh address, it is an advantage to use the DP8408A 8-bit refresh counter to support 64k dynamic RAMs directly. The DP8408A refresh counter is incremented as MREQ returns high, ending the memory refresh. The RFSH goes inactive returning the DP8408A back to the Auto Access mode, preparing it for the next access cycle.

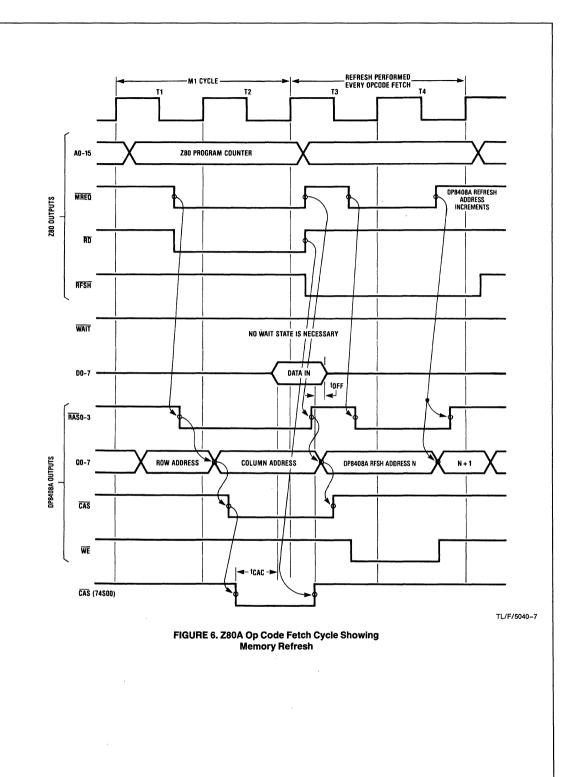






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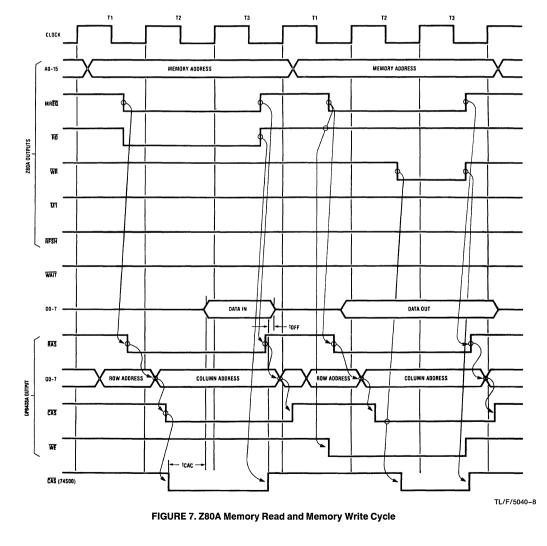


#### MEMORY ACCESS CYCLE

Figure 7 shows the timing of the memory read and memory write cycle other than for the M1 op code fetch cycle. Similar to the op code fetch cycle, MREQ is used to provide RASIN. MREQ goes active after the address to the memory has had time to stabilize. Again, RAS output, Row to Column Select and then CAS output will automatically follow RASIN to access the specified memory location. For a memory read cycle, both MREQ and RD go active, and as a result, WIN remains high (refer to Figure 5), which allows a memory read operation to cocur. On the other hand, only MREQ goes active during a write cycle, which forces WIN low, indicating an early write cycle. It should be noted that the CAS output to the memory array will not go low until WR goes low during memory write cycles as this guarantees the valid CPU data will be written into memory.

It is worth mentioning that the Z80 CPU provides powerful block transfer instructions. An example is the LDIR (load, increment and repeat); using only this instruction, the programmer can move any block of data from the location pointed to by the D and E registers. This operation is repeated until the byte counter (B and C registers) reaches zero. Thus, this single instruction can move any block of data from one location to any other. Due to the fact that this instruction is refetched after each data byte transfer, the memory refresh cycle always takes place even though a transfer of up to 64k bytes of data may be performed. Furthermore, when the CPU has executed the software HALT instruction and is waiting for an interrupt before normal CPU operations can resume, the CPU executes NOP instructions to maintain memory refresh activity.

However, care should be taken when the CPU is in either WAIT state or a Bus Acknowledge cycle, the dynamic RAM refresh will not take place. If these conditions occur long enough, a burst refresh is recommended, and it can be done by toggling  $\overrightarrow{RASIN}$  while keeping M2 low until all the rows of the dynamic RAM have been refreshed before the CPU can resume its operation.



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The following formulas allow designers to select the appropriate dynamic memory, based on different CPU and DP8408A speed versions, to allow the CPU full speed of operation:

 $\begin{array}{l} \text{max.} t_{\text{CAC}}: 1.5 \times t_{\text{Cmin}} - t_{\text{DL}\varphi}(\text{MR}) - t\text{RICL} - \\ t_{\text{CASDLY}} - t_{S\varphi}(\text{D}) \\ \text{min.} t_{\text{RP}}: \text{tw}(\text{MRH}) = \text{tw}(\varphi\text{H}) + t_{\text{f}} - 20 \\ \text{min.} t_{\text{RAS}}: \text{tw}(\text{MRL}) - 20 = t_{\text{C}} - 50 \end{array}$ 

**Dynamic RAM Parameters:** 

t<sub>CAC</sub>: access time from CAS

t<sub>RP</sub>: RAS precharge time

tRAS: RAS pulse width

#### Z80 Parameters:

t<sub>C</sub>: clock period

- tw( $\phi$ H): clock pulse width, clock high
  - tf: clock fall time
- $t_{DL\varphi}(MR): \frac{MREQ}{MREQ}$  delay from falling edge of clock,  $\frac{MREQ}{MREQ}$  low
  - $t_{S\varphi}(D)\text{:}$  Data set up time to rising edge of clock during M1 cycle

DP8408A and 74S00 Parameters:

- t<sub>RICL</sub>: RASIN to CAS output delay
- $t_{\mbox{CASDLY}}$ : propagation delay of the two 74S00 NAND gates

For example, if the Z80A (4 MHz) and the DP8408A are used, then:

max.  $t_{CAC}$ : 1.5(250) - 85 - 132 - 13 - 50=95 ns min.  $t_{BP}$ : 110 + 20 - 20=110 ns

min.  $t_{BAS}$ :  $t_C - 50 = 200 \text{ ns}$ 

t<sub>RICL</sub> max.

(mode 6): 132 ns at 15 pF load

t<sub>CASDLY</sub> max.: 13 ns at 50 pF load

Therefore, in this case, the designer should choose a dynamic memory which has maximum  $t_{CAC}$  of 95 ns, minimum  $t_{RAS}$  of 110 ns and minimum  $t_{RAS}$  of 200 ns.

### DP8409A and MC68B09E Interface

#### **DP8409A OVERVIEW**

The DP8409A Dynamic RAM Controller/Driver is designed to control all multiplexed-address dynamic RAMs. It consists of two 9-bit address latches and a 9-bit refresh counter, thus allowing control of all 16k, 64k, and the coming generation 256k dynamic RAMs. More important, all the DP8409A outputs are capable of driving 500 pF loads.

The DP8409A basically has eight modes of operation: Externally Controlled Refresh, Automatic Forced Refresh, Internal Auto Burst Refresh, All RAS Auto Write, Externally Controlled Access, Auto Access (slow  $t_{RAH}$  and with hidden refresh), Fast Auto Access (fast  $t_{RAH}$ ) and Set End of Count. Of all these modes, Auto Access (mode 5) and Auto Forced Refresh (mode 1) are the most popular and will be used throughout this application. Mode 5 requires only RASIN to initiate a memory access cycle, because all the

dynamic RAM's control signals are automatically delayed from this input, as shown in *Figure 1*. To attain maximum system throughput, it is obviously advantageous to perform refreshes without interrupting the system. The DP8409A can do this by monitoring the  $\overline{CS}$  input to see if it is high. If  $\overline{CS}$  is high, the RAMs are not being accessed. If  $\overline{CS}$  is high for one cycle, the DP8409A performs a hidden refresh during this cycle, and stops in time for the system to start another access. But if a hidden refresh does not occur in a specific time slot, a refresh must be forced and this can be done by using Mode 1, Automatic Forced Refresh.

To perform automatic forced refresh, the DP8409A must receive two clock signals: the refresh period clock, RFCK, and RGCK, the RAS-generator clock; RGCK can be the microprocessor clock. It takes approximately four RGCK clock periods to perform this automatic forced refresh. The DP8409A gives preference to hidden refresh using RFCK as a level reference. The refresh time slot commences as RFCK goes high. If CS goes high while RFCK is high, the refresh counter is enabled in the address outputs. All four RAS outputs follow RASIN; so to perform a hidden refresh, RASIN must be set low and the refresh counter gets incremented as RASIN goes high. The DP8409A allows only one such hidden refresh to occur with a clock cycle of RFCK to minimize power consumption.

If a hidden refresh does not occur the DP8409A must force a refresh before RFCK begins a new cycle on a low-to-high transition. Therefore, as RFCK goes low (and a hidden refresh has not occurred), RF I/O (Refresh Request) goes low, requesting that a refresh be performed. When the system acknowledges the request, it sets M2 low, and prevents further access to the DP8409A. Then two RGCK negative edges after M2 has gone low, all four RAS outputs go low and remain low for two RGCK clock periods. After all four RAS outputs have gone low, M2 can go high any time to end the Automatic Forced Refresh. The DP8409A allows only one automatic refresh to occur within a clock cycle of RFCK.

#### MEMORY ACCESS

The MC68B09E starts a memory access cycle when E goes low, then the memory address becomes valid on the Address Bus A0-15. This address is decoded to provide Chip Select (CS) to the DP8409A. Then Q goes high and sets RASIN low from the PAL® Control Logic as shown in Figure 12. Note that  $\overline{CS}$  must go low for a minimum of 10 ns before the assertion of RASIN for a proper memory access. This is important because a false hidden refresh may take place when this 10 ns minimum setup time is not met. RASIN goes low initiating the auto access sequence as shown in Figure 1. Mode 5 guarantees a 30 ns minimum for row address hold time and a minimum of 8 ns column address set up time. RASIN remains low until E goes low at the end of the current access cycle. Using the 16R6A Programmable Array Logic (25 ns PAL), the maximum access time from CAS of the selected dynamic RAM is determined as follows:

Max. t<sub>CAC</sub>: 3×125-25-160-40=150 ns 8409A

 $t_{CAC}$ : 3×125-25-130-40=180 ns 8409A-2 Q high to

E low: 3 imes 125 ns (8 MHz clock)=375 ns

#### Q high to

RASIN low: 25 ns (16R6 A PAL Parameter) RASIN to CAS

Output low: 160 ns (DP8409A's t<sub>RICL</sub>, Mode 5, at 500 pF load)

130 ns (DP8409A-2's t<sub>RICL</sub>)

Read data setup

time (before E

going low): 40 ns

#### MEMORY REFRESH

As described above,  $\overline{\text{RASIN}}$  goes active when Q and/or E are high. This scheme, therefore, maximizes chances for hidden refresh because  $\overline{\text{CS}}$  is high during nondynamic memory cycle. For example, when the CPU is executing internal operation or the CPU is accessing ROM or I/O,  $\overline{\text{CS}}$  is high during these times. The DP8409A therefore performs a hidden refresh as  $\overline{\text{RASIN}}$  goes low, assuming that RFCK is high.

However, if no hidden refresh occurs while RFCK was high, RF I/O goes low immediately after the RFCK high-to-low transition requests a forced refresh. The PAL Control Logic samples RF I/O, when E and Q are high and low respectively, to set M2 (RFSH) low, as shown in Figure 13. Once M2 has gone low, a forced refresh automatically occurs (as described in the DP8409A Overview). M2 remains low for four system clock periods to allow for this forced refresh. If the current microprocessor cycle is a nondynamic memory cycle (CS is high), this refresh is transparent to the microprocessor and STRETCH remains high (E and Q are not stretched). Nevertheless, if the current cycle is a dynamic memory access cycle, STRETCH goes low stretching E and Q for a maximum of four system clocks. RASIN for the pending access will be issued a full system clock after M2 has gone high: this is to allow some RAS precharge time for the dynamic RAM. After this, memory will be accessed in the manner as described in the Memory Access Cycle.

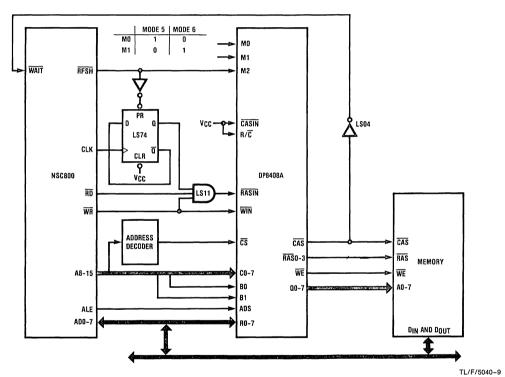
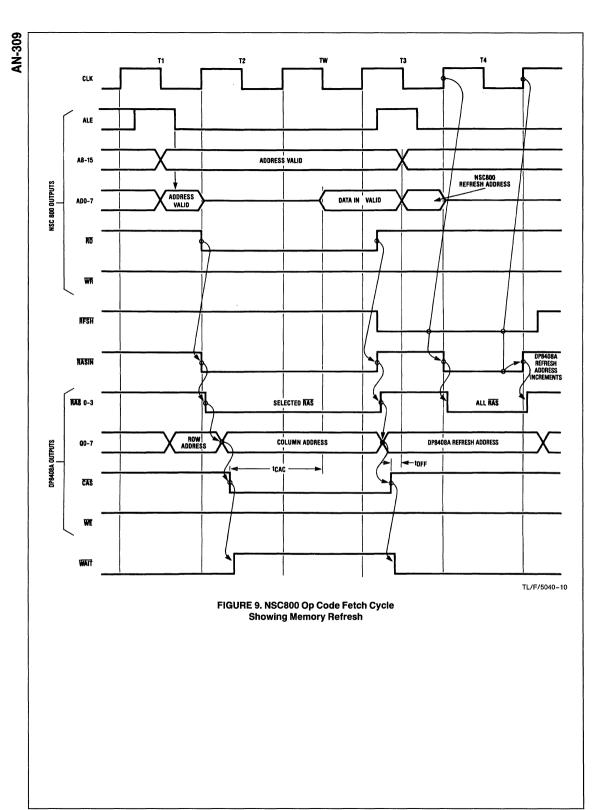
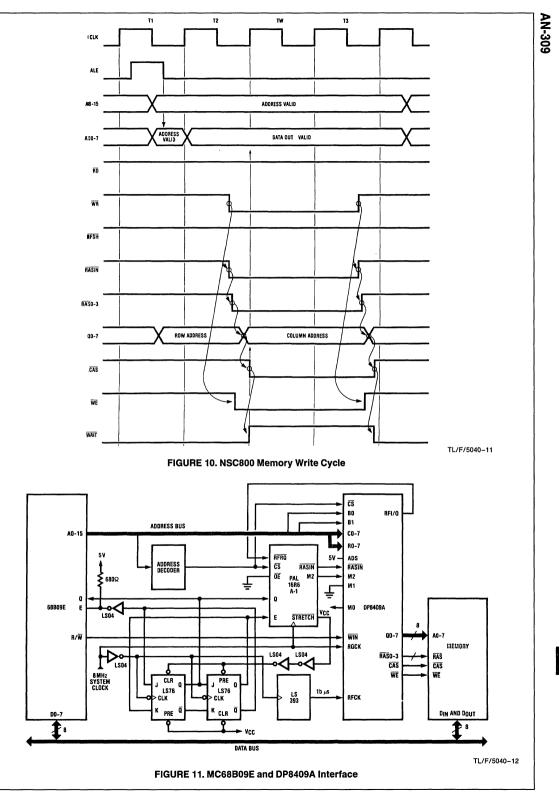


FIGURE 8. NSC800 and DP8408A Interface

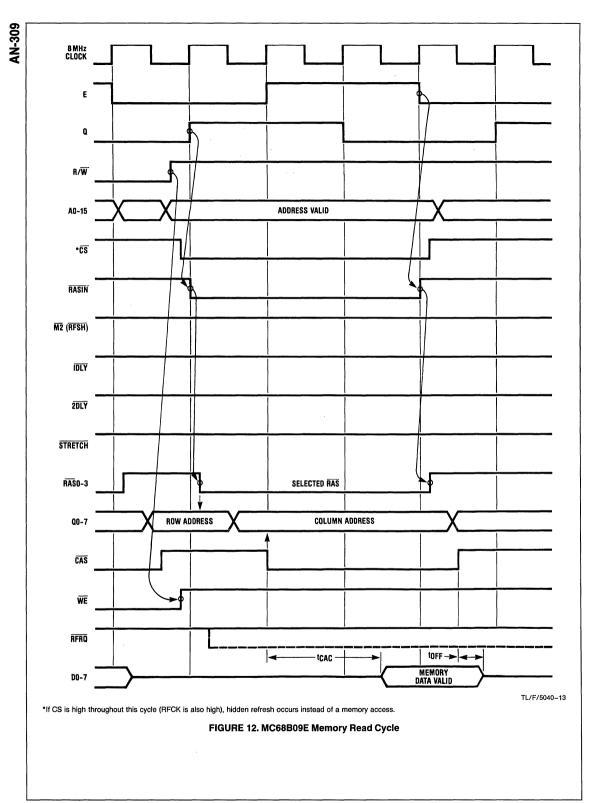
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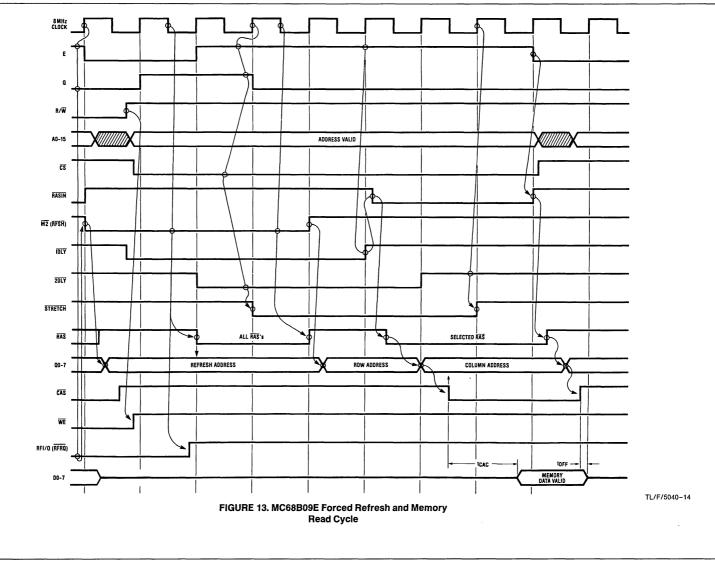




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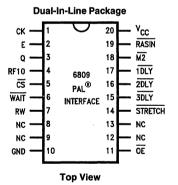
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## AN-309

PAL16R6A User Part # 6809/8409A Interface PAL National Semiconductor CK E Q RFIO /CS /WAIT RW A B GND /OE C D /STRETCH /3DLY /2DLY /1DLY /M2 /RASIN VCC If (VCC) RASIN=CS\*E\*/M2\*/1DLY + CS\*Q\*/M2 M2:=E\*/RFIO\*/Q + M2\*/3DLY 1DLY:=M22DLY:=1DLY 3DLY:=2DLY STRETCH: =  $CS^*2DLY^*E +$ CS\*WAIT\*E\*Q\*RW :DESCRIPTION:

;The above equations are written in standard PALASMTM format. ;Also included in the logic is a ""/WAIT"" (active low) input. This ;input will allow the insertion of one WAIT state in a READ ;access cycle if it is tied low. If WAIT states are wanted in ;both READ and WRITE access cycles the ""RW"" input in the STRETCH ;equation should be deleted.

;The user should make sure that CS is valid at the DF8409A input a ;minimum of 30 ns before RASIN is valid. If the user does not ;care about the HIDDEN REFRESH feature of the DF8409A, CS can be ;tied permanently low. In this configuration the RASIN term can ;transition whenever is convenient.



TL/F/5040-15

## DP8400/8419 Error Correcting Dynamic RAM Memory System for the Series 32000<sup>®</sup>

#### INTRODUCTION

Three PAL's<sup>®</sup> (Programmable Array Logic devices) were used in this application in order to interface between the NS32016, DP8419 and the DP8400 to produce an error correcting memory system for the Series 32000 microprocessor family. The PAL Interface Controller (hereafter referred to as P.I.C.) takes care of all interfacing logic, no extra control logic is needed.

#### FEATURES

- The P.I.C. controls the following types of cycles:
  - A) READ cycles with no errors detected, ALWAYS CORRECT MODE (1 WAIT state inserted).
  - B) READ cycles with single error detected, the correct data will be written back to memory and given to the CPU. One WAIT state is inserted into the READ cycle and one WAIT state is inserted into the next access cycle (and the access is delayed) if it immediately follows the READ cycle.
  - C) READ cycles with more then one error detected. In this case the processor is interrupted and appropriate action can be taken.
  - D) WRITE cycles (no WAIT states).
  - E) BYTE WRITE cycles, or READ MODIFY WRITE cycles (3 WAIT states inserted). If more then one error is detected in the READ portion of this cycle the processor will be interrupted so appropriate action can be taken.
  - F) DRAM REFRESH cycles (may cause a maximum of 5 WAIT states to be inserted into an access cycle if the access occurs while the refresh is taking place).
- All single bit errors are automatically corrected and rewritten back to memory.
- All double bit errors are detected and cause a system interrupt.
- Can directly drive up to 2M bytes of Dynamic RAM (4 banks of 22 256k DRAMS, each bank being 16 data bits plus 6 check bits).
- The P.I.C. allows full use of the DP8400 and all its modes of operation, including:
  - A) The DIAGNOSTIC modes (can do a diagnostic test of the DP8400 without needing to use external memory).
  - B) The COMPLEMENT modes (useful for doing the DOUBLE COMPLEMENT METHOD to try to correct 2 errors).
- The P.I.C. interfaces between the DP8409A or DP8419 Dynamic RAM controller, the DP8400 Expandable Error Checker and Corrector, the NS32016 processor, the NS32201 Timing Control Unit, and the NS32082 Memory Management Unit (if used in the system).
- Provides outputs to interrupt the CPU and to insert WAIT states if needed.

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- This interface uses PAL's whose equations and timing are given, allowing the user to customize the interface to his own requirements (even a different processor family) if he so desires.
- Can work at 10 MHz (using the new DP8419, DP8400-2, and common 120 ns 64k DRAMs). Operation at higher frequencies is possible.

#### DESCRIPTION

The P.I.C. consists of 3 PAL's and one 74LS164 parallel output serial shift register (see P.I.C. logic diagram). If greater speed is needed for the shift register (CPU clock speed is over 6 MHz) one could use some similar type of shift register in a faster type of logic ("AS, ALS, F"), or could make one out of D flip-flops (74AS174).

If one is using a CPU other then the Series 32000 and does not have a fast clock (FCLK, twice system clock frequency) he could substitute a 5 or 10 tap delay line for the shift register.

The P.I.C. uses a shift register as an aid in determining the state of the CPU and where it is in an access cycle. When either of the two outputs, "FASIN" or "RFSH", go true the shift register is enabled and begins producing a series of delays. These delays, along with specific signals from the CPU, are used in the interface to determine the state of the CPU and create the appropriate control signals for the DP8400, the DP8409A/DP8419, and the processor. Other CPUs should be able to customize this interface to their requirements by adjusting the appropriate equations.

The logic in the upper right hand corner of the P.I.C. logic diagram may not be needed (74LS374's, 74LS244, 74LS240's LED's and several SSI gates). The logic allows the latching of the DRAM bank (BA17, BA18), the syndrome (S0–S7), and the error flags (AE, E0, E1) during an error condition. The latched data will be displayed on the LED's (until the I/O RESET signal is applied) and can be read from the data bus by the CPU. The address in error could also be latched by this same logic, if desired.

The 2 input AND gate (U5) in the upper left of the P.I.C. logic diagram holds  $\overline{CS}$  low until after RASIN goes high on the DP8409A/19. This is particularly useful for READ cycles with one ERROR where RASIN is extended beyond the end of the current cycle, perhaps into another access cycle.

In this application double bit errors, in the dynamic RAM, generate an interrupt to the CPU. All single bit errors are automatically corrected and rewritten back to memory.

During a SYSTEM RESET the internal flip-flops of PAL #1 are set to a refresh state by making the RESET input look like a refresh request (External logic was used to "NOR" the DP8409A/19 RFI/O input with a system RESET input to produce the PAL #1 RFI/O input).

The P.I.C. performs HIDDEN REFRESHES (CPU not accessing the Dynamic RAM controlled by the DP8409A, indicated by "/CS" being high) assuming a 4 "T" state processor access cycle.

The P.I.C. allows the full use of the DP8400 and all its modes of operation. For example, the DP8400 has excellent diagnostic capabilities included in modes "2" and "6". These modes allow one to perform a complete diagnostic test of the DP8400 without using the external memory. This is possible using an I/O port to control "M1 and M0" of the DP8400, along with the diagnostic control signals "DIAGCS and DIAGD" as follows:

- The user can set the I/O signals "M1" and "DIAGCS" both high and perform a mode 2 DIAGNOSTIC WRITE to the DP8400 with user generated CHECK bits on the high byte of the data bus. The CHECK bits will be latched into the DP8400 (CSLE held low) until the user sets the I/O signal "DIAGCS" low.
- 2) The user can then set the I/O signals "M1" low and "DIAGD" high and perform a mode 0 WRITE, latching the user generated data in the DP8400 input latches (DLE held low)."
- 3) Next, the user can perform a normal mode 4 READ. This will in effect be a diagnostic READ of the user generated data and check bits without using the external memory. In this way the DP8400 can be completely checked out during system initialization.
- 4) The syndromes, check bits, and error flags can also be read, provided ODLE, OB0, and OB1 are low, using mode 6A or by reading the latches.
- 5) When the diagnostics are completed the user can return the DP8400 to normal functioning by resetting the I/O port outputs to the original DP8400 operating mode values ("M0, M1, DIAGCS, DIAGD" all low, and "I/O RESET" high).

Using the I/O port signal "M0" the user could perform the DOUBLE COMPLEMENT METHOD to try to correct a DOU-BLE bit error in the DRAM (see DP8400 data sheet for further information on the DOUBLE COMPLEMENT METH-OD).

Another I/O port output, "I/O RESET", allows the outputs "DOUBLERROR" and "ERROR" in PAL #3 to be reset. The signal "ERRLAT" is used in this interface to latch the SYNDROME, DRAM bank, and ERROR flags during a CPU READ access with a single, double, or triple bit error. The CPU can READ these latched error signals by performing a memory READ from a specific memory location. (An OFF BOARD CHIP SELECT, "CS-OFFB".) This READ will gate the latched error condition to the CPU data bus via the 74LS244 buffer and the signal SYNDROME-DATA (see the upper right hand corner of the P.I.C. controller logic diagram).

The PAL equations that follow are in the National Semiconductor PLANTM format, which differs from the standard PALASMTM format.

#### EXAMPLE: PLAN FORMAT

#### "RASIN := RFSH \* 2D \* ODLE"

This translates as, "RASIN" is low after the rising edge of the input clock given that "RFSH" was high and "2D" was low and "ODLE" was high a setup time before the clock transitions high (here RASIN, RFSH, and ODLE are outputs of the PAL and 2D is an input).

EXAMPLE: PALASM FORMAT

#### "RASIN := RFSH \* 2D \* ODLE"

The above expression means the same as the PLAN format expression except it is written in PALASM format. In other words "RASIN" will go low after the rising edge of the clock given that "RFSH" was high, "2D" was low and "ODLE" was high a setup time before the clock transitions high (here RASIN, RFSH, and ODLE are outputs and 2D is an input).

Depending on the Specific type of PAL's and logic used the user can calculate the speed requirements for the DRAM at the specified processor frequency as follows:

Here both "t<sub>RAC</sub>" and "t<sub>CAC</sub>" must be calculated and considered in determining what speed DRAM can be used in a particular system design. The DRAM chosen must meet both the "t<sub>RAC</sub>" and "t<sub>CAC</sub>" parameters calculated.

EXAMPLE SYSTEM, 10 MHz, DP8400-2, DP8419, FAST "A" PART PALs

- #1)  $\overrightarrow{\text{RASIN}}$  low = T1-2 ns (F<sub>CLK</sub>-PHI1 skew)+15 ns ("A" PAL clocked output) = 100-2+15 = 113 ns maximum
- #2)  $\overline{\text{RASIN}}$  to  $\overline{\text{RAS}}$  low = 20 ns maximum (DP8419)
- #3) RASIN to CAS low = 80 ns (DP8419 RASIN-CAS low maximum)
- #4) 74F244 transceiver delay = 7 ns maximum
- #5) DP8400-2 data setup time to "CSLE, DLE" = 10 ns maximum
- #6) Minimum "CSLE, DLE" delay into "T3" = Minimum "A" PAL delay - minimum FCLK to PHI1 skew = 8
   - 2 = 6 ns minimum
- $\label{eq:hardware} \begin{array}{l} ``t_{\mathsf{RAC}}" = \mathsf{T1} + \mathsf{T2} + \mathsf{TW} \,\# \mathsf{1} \,\# \mathsf{2} \,\# \mathsf{4} \,\# \mathsf{5} + \,\# \mathsf{6} \\ \\ = \,100 \,+ \,100 \,+ \,100 \,- \,113 \,- \,20 \,- \,7 \,- \,10 \,+ \,\mathsf{6} \\ \\ = \,156 \; \mathsf{ns} \end{array}$
- $$\label{eq:transform} \begin{split} ``t_{CAC}'' &= T1 + T2 + TW \#1 \#3 \#4 \#5 + \#6 \\ &= 100 + 100 + 100 113 80 7 10 + 6 \\ &= 96 \ \text{ns} \end{split}$$

Therefore the DRAM chosen should have a "t<sub>RAC</sub>" less than or equal to 156 ns and a "t<sub>CAC</sub>" less than or equal to 96 ns. Standard 150 ns DRAMs meet this criteria.

Approximately 150 ns minimum RAS precharge time.

Approximately 200 ns minimum CAS precharge time.

Approximately 230 ns minimum RAS pulse width.

Approximately 180 ns minimum CAS pulse width.

One must also consider the WRITE command to TAS and CAS lead times when choosing DRAMs for this system. During a READ access cycle, with a single bit error, a READ-MODIFY-WRITE access is performed. Here, the WRITE command to TAS and CAS lead times are one half period in length. This may present a problem to systems operating at frequencies of 10 MHz or greater. One can alleviate this problem by inserting an extra WAIT state into READ access cycles (see Use of P.I.C. at higher operating frequencies, #3) or by using external drivers from the PAL "WE" output to the DRAM "WE" input (thereby speeding up the WIN to WE delay and guaranteeing a greater WE to TAS and CAS lead time).

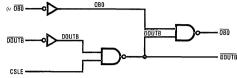
#### USE OF THE P.I.C. AT HIGHER FREQUENCIES

1) If one is using this interface above 4–6 MHz he should consider using the fast PAL's\* (example "PAL16R8A" instead of "PAL16R8"), a fast shift register (example 74F164), external fast logic (such as "AS, ALS, or F" type 74XX series) or the faster "B" type PALs to produce outputs "DOUTB,  $\overline{OB0}$ ,  $\overline{OB1}$ " to the DP8400, and the new DP8400-2 error correction chip. The fast PAL's\* have an input to output maximum time of 25 ns, and 15 ns if it is a registered output. The slow PAL's\* have an input to output maximum time of 35 ns, and 25 ns if it is a registered output.

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One needs to produce "DOUTB, OB0, OB1" faster at higher CPU speeds to guarantee that the CPU reads valid data during a READ access cycle. To do this he could use external fast logic as shown in the following figure.

Using the above example we can calculate (assuming a 10 MHz 32000 series processor) the time required to have valid data at the CPU data input pins.





@OB1 would have the same configuration as OB0

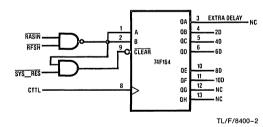
13 ns (maximum time of CSLE into state T3 assuming fast "A" PAL) +9 ns (maximum 74ALS00 propagation delay) + 9 ns (max 74ALS00 prop delay) +36 ns (maximum DP8400-2 "OB0, OB1" to output valid delay) + 7 ns (maximum 74F245 propagation delay) + 20 ns (data setup time required for the series 32000 with respect to the CTTLclock) = 94 ns \*\*\*This value must not exceed 100 ns for a 10 MHz processor.

The delay of "DOUTB" is to allow the DP8400 data, check bit and syndrome latches "DLE, and CSLE" to latch the data and check bits before turning off the DRAM output buffers.

The delay of " $\overline{OB0}$  and  $\overline{OB1}$ " allow the DRAM output buffers to turn off before the DP8400 starts driving the DP8400 memory data bus. In general the DRAM output buffers should turn off much faster then the DP8400 output buffers can turn on, so the user may want to allow " $\overline{OB0}$ ,  $\overline{OB1}$ " to become valid at the same time as " $\overline{DOUTB}$ " transitions high.

2) In order to allow the use of slower DRAMs at higher CPU speeds one may want to slow down access cycles by adding an extra WAIT state.

To do this one could replace the 74LS164 IC with the following circuit:



Here "CTTL" was used instead of "FCLK" with a 74F164. The "RFSH" PAL equation must be adjusted to keep "RFSH" 5 clock periods long, as follows:

RFSH: = RFIO\*INCY\*2D + RFSH\*RFIO + RFSH\*6D + RFSH\*CTTL

)

If WAIT states are also wanted in WRITE access cycles the "CWAIT" equations must include the following term:

#### + RFSH \* INCY \* TSO \* DDIN \* 2D

If one wants to keep WRITE cycles without WAIT states inserted then the "RASIN" equations must be modified for HIDDEN REFRESH and WRITE cycles as follows:

#### + RFSH \* RASIN \* INCY \* 2D

3) Another possibility for this interface at higher frequencies would be to adjust READ access cycles by adding another WAIT state to them, as well as adjusting BYTE WRITE cycles.

Using this method one would need another stage for the shift register or use a 74F164 and use CTTL as its clock instead of FCLK. If one looks at the above figure, using the 74F164, for reference the extra stage "10D" would be used. This would allow one to make the READ access cycle one "T" state longer by adjusting the READ and READ with error "RASIN" equations.

To make the READ access cycle one "T" state longer another WAIT state would have to be added to READ cycles (making a total of 2 WAIT states) and the latch signals "ODLE" and "CSLE" must be adjusted by delaying them back  $\frac{1}{2}$  "T" state (allowing a  $\frac{1}{2}$  cycle longer access time). This also has the advantage of allowing the other  $\frac{1}{2}$  cycle of time to get the data valid at the inputs of the Series 32000 CPU.

The BYTE WRITE access cycle could also be adjusted by delaying the signals " $\overline{ODLE}$ " and "CSLE" by 1/2 cycle. No other equations need to be touched. This would allow an extra 1/2 cycle for access time during BYTE WRITE access cycles.

This would allow a standard 150 ns to possibly 200 ns DRAM in a 10 MHz system [80.5 ns +  $1_{\!/\!2}$  "T" state (50 ns) = 130.5 ns column access time (t<sub>CAC</sub>)] but would sacrifice by having 2 WAIT states in READ access cycles.

4) One also must be careful to make sure that  $\overline{CS}$  is low, during an access, a minimum of 30 ns (DP8409A, 15 ns DP8419) before  $\overline{RASIN}$  transitions low. If this is a problem one could tie  $\overline{CS}$  permanently low (disabling hidden RE-FRESH) and use the system transceivers to select the memory system.

#### **OTHER OPTIONS**

If one is using the NS32082 Memory Management unit in a Series 32000 system he should connect the output "PAV" (Physical Address Valid) to the P.I.C. instead of the address strobe output "ADS".

An output for the BUS PARITY ERROR in a data transfer from the CPU to memory could also be detected, from the error flags and "AE" of the DP8400, and used to interrupt the CPU. However, the P.I.C. does not make use of that feature of the DP8400, though it would be very easy to add. If one does not want to WRITE corrected data to memory in case of a DOUBLE BIT error, in READ access cycle, he could disable the WRITE signal, "WIN", during a DOUBLE BIT error as follows:



TL/F/8400-3

## NS32016, DP8400, DP8409A PALs Inputs and Outputs

| <ul> <li>PAL #2 Outputs</li> <li>PAL #1 Outputs</li> <li>"CK" Fast Clock (twice "CTTL" frequency of from NS32201.</li> <li>"CG" Output clock from NS32201.</li> <li>"DTN" Output clock from NS32016, indicates the direction of the data bus.</li> <li>"DTN" Output clock is in an access cycle.</li> <li>"RFIO" FRIO" Chapter of the start causes the start causes are start in the rest of the processor, strough the CPU transcetver, onto the DP8400.</li> <li>"NOT" Output clock is in an access cycle.</li> <li>"CDTN" Output clock and high byte entite the NS2016 is in an access cycle.</li> <li>"CDT" "COutput from PAL #2 indicating that the NS2016 is in an access cycle.</li> <li>"CDT" "CTL" "GTTL" "Output from PAL #2 indicating that the NS2016 is in an access cycle.</li> <li>"CDTT" "CTL" "CTL" "GTTL" "Greet the trans of the processor, clock from NS32010 is an access cycle.</li> <li>"CD" "TRSN" or "RFSH" delayed by 2 periods of FCLK. This output from PAL #3 indicating that any error, "AC," was valid uting a HEAD access cycle.</li> <li>"CD" "TSD" "COutput from PAL #2 indicating that any error, "AC," was valid uting a may error was an uput of the extern and shift register.</li> <li>"FOT" "TSO" "Duput from PAL #1 minimates the process cycle.</li> <li>"FOT" "TSO" "Duput from NS2016, the process cycle.</li> <li>"FOT" "TSO" "Duput from PAL #1 the indicates the bear error may but may error more process.</li> <li>"FOT" "TSO" "Duput fr</li></ul>                                                                                       | PAL   | _s Inputs     | and Outputs                       | DAL | #2 Outpute        |                                      |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|---------------|-----------------------------------|-----|-------------------|--------------------------------------|
| PAL #1 Inputs         Faal Clock (twice "CTL" frequen-<br>0) from NS32201.         Control the DP8400/<br>Memoy data bus.         DP8400/<br>Memoy data bus.           1""GS"         Output foots from NS32201.         18)         "OBT"         Control the DP8400/<br>Memoy data bus.         Cont                                                                                                                                                                                                                                                                                                                                                                                                        | PIN N | UMBER OF TH   | E PAL ON THE LEFT                 |     |                   | This signal enables the high byte of |
| 1)       "FCLK"       Fast Clock (wice "CTTL" frequency) (Mannoy data bus.         2)       "CTTL"       Output clock from NS32201.       18         3)       "CS"       Chip Select for the Dynamic RAM controlled by the OP8409A and DP8400.       17       "OBT"         4)       "DDR"       Data Direction in, from NS32016, indicates the direction of the data transfer during a bus cycle.       18       "OBT"       This signal enables the low byte of the DP8409A, also is used as a reset input to set PAL to a known state.       10       "PBUFO       This signal enables the West of the DP8409A, and the DP8409A, also is used as a reset input from NS22016 is in an access cycle.       15       "DOUTB"       Controls DP8400 output buffer for byte origination to the DP8400A monother CPU transceiver, onto the DP840A mo                                                                                                                                                                                                                                                                                                                                                                                                  |       |               |                                   | ,   |                   |                                      |
| <ul> <li>c) "CTU" Output fock from NS32201.</li> <li>"CTU" Output fock from NS32201.</li> <li>"CST" Chip Select for the Dynamic RAM controlled by the DP8409A and DP8400A and</li></ul>                                                                                        |       |               | East Clock (twice "CTTL" frequen- |     |                   | transceiver, onto the DP8400/        |
| 2)       "CTTL"       Output block from NS32201.       18)       "OBI"       Controls DP8400 output bluffer for byte"".         3)       "CS"       Chip Select for the Dynamic RAM controlled by the DP8409A and DP8400.       17)       "OBI"       Controls DP8400 output bluffer for byte"".         4)       "DDN"       Data Direction in, from NS32016, indicates the direction of the data transfer during a bus cycle.       16)       "PBUO"       This signal enables the weet the DP8400A, also is used as a resot input to set PAL to a known state.       100       Output form PAL 4? indicating that the NS32016 is in an access cycle.       14)       "INC?"       Output form NS32016 is used as a resot inno the NS32016 is in an access cycle.       14)       "INC?"       Output form NS32016 is bus cycles to have mine when byte operations are in more when byte operations are in more when byte operations are in more maker (mon NS32016 is bus cycles.         8)       "2D"       "REREAT"       Output form PAL 4? indicating that any error, "AE" was valid during a min ary error, "AE" was valid during a min a shift register.       9)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | ''    | 1 OEK         |                                   |     |                   |                                      |
| <ul> <li>3) "CS" Chip Select for the Dynamic RAM controlled by the DP8409 and DP8400.</li> <li>4) "DDRIN" Data Direction in, from NS32016, and the processor, through the CPU transceiver, onto the DP8400, also is used as a reset input to set PAL to a known state. DP8400, also is used as a reset input to set PAL to a known state. The NS2016 is nan access cycle.</li> <li>7) "ACHBE" Referst request output from the DP8400, also is used as a reset input to set PAL to a known state. The NS2016 is nan access cycle.</li> <li>7) "ACHBE" The Additional Sub Solution of PAL # 2 Inputs</li> <li>8) "2D" "RASIN" or "RFSH" delayed by 2 periods of RFCK, falso an output of the external shift register.</li> <li>9) "ERILAT" Output from PAL # 2 Indicating and any error, "AC", was valid during a RFAD access cycle.</li> <li>10) "6D" "4D" delayed by 2 periods of RFCK, falso an output of the external shift register.</li> <li>11) "CF" Enables PAL outputs.</li> <li>12) "4D" "4D" delayed by 2 periods of RFCK, falso an output of the external shift register.</li> <li>13) "4D" OUTPUT from PAL # 1 that indicates the paralexit is used in many other gelaxions and inturtions as a sign at limit register.</li> <li>14) "CYCLED" This output is used in many other gelaxions and inturtions as a sign and shift register.</li> <li>14) "CYCLED" This output is used in many other gelaxions and inturtions as a sign and shift register.</li> <li>14) "CYCLED" Output from PAL # 1 that indicates the paralexis and shift register.</li> <li>14) "CYCLED" Chapter the DRAM access cycle.</li> <li>"TASIN" Output from PAL # 1 that indicates the paralexis and input to PP8409A. It causes a WRITE input to DP8409A. It causes a WRITE input to DP8409A. It causes a WRITE input to DP8409A. It causes a WRITE input to PP8409A. It causes a WRITE input to PP8409A. It causes a WRITE input to more the DRAM access cycle.</li> <li>"TASIN" Output from PAL # 1 that indicates the paralexis and input top PAL # 2 Outputs</li></ul>                                                                                                                                                                  | 2)    | "CTTL"        |                                   | 18) | "OB1"             |                                      |
| <ul> <li>a) "DDIN" Data Dreation in from NS32016, indicates the direction of the data starsfer during a bus cycle.</li> <li>5) "RFIO" Taraffer during a bus cycle.</li> <li>6) "RFIO" Refresh request output from the DP4009A, also is used as a reset input to set PAL to a known state.</li> <li>6) "INC?" Output from PAL # 2 indicating that the NS32016 is in an access cycle.</li> <li>7) "ROFIE" If address bit 0 and high byte enable (from NS32016) and high byte enable (from NS32016) are access cycle.</li> <li>8) "2D" "RASIN" of "RFSH" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>9) "ERFLAT" Output from PAL # 3 indicating that any error, "AE", was valid during an shift register.</li> <li>10) "GE" Enables PAL outputs.</li> <li>11) "GE" also an output of the external shift register.</li> <li>12) "GOUTS" This output is used in any other real shift register.</li> <li>13) "GD" "GO" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>14) "GYCLED" This output is used in any other real shift register.</li> <li>15) "WINI" This output is used in any other real shift register.</li> <li>16) "GDIT" "GOUTG" This output is used as an input to the DP4009A, causes the DP4009A to enter mode 1 to do a refresh.</li> <li>16) "WINI" This output is used as an input to the DP4009A, causes a WITE to the DP4009A, causes a WITE to the DP4009A, causes a WITE to the DP4009A, to access cycle is midway to completion.</li> <li>11) "GYCLED" This output is used in anay other equations and functions as a signing of a selected DP400 (regions) are in progress.</li> <li>11) "GYCLED" Output from PAL # 1 that indicates whether the DPA00A, access a WITE to the DP400A, acce</li></ul>                                                                                       |       | " <u>CS</u> " |                                   |     |                   |                                      |
| <ul> <li>a) "DDIN" Data Direction in, from NS32016, indicates the direction of the data transfer during a bus cycle.</li> <li>a) "RFIO" Refresh request output from the DP4409A, also is used as a reset input to set PAL to a known state. Output from PAL #2 Indicating that the NS32016 is an access cycle.</li> <li>b) "RCY" Output from PAL #2 Indicating that the SS2016 is an access cycle.</li> <li>c) "DOUTE" Control memory data bus.</li> <li>c) "TROY" Output is high. Used to determine when byte operations are in progress.</li> <li>a) "2D" "RASIN" or "RFSH" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>c) "GVTTL" Spreaded by 2 periods of RGCK, also an output of the external shift register.</li> <li>c) "CYCLE" This output is used as an input to the DP400A, causes a wilt register.</li> <li>c) "CYCLE" This output is used as an input to the DP400A, also an output of the external shift register.</li> <li>c) "GVTTL"</li> <li>c) "GVTTL"</li> <li>c) "GDTT"</li> <li>c) "GVTTL"</li> <li>c) "GDTT"</li> <li>c) "GTTL"</li> <li>c) "GDTT"</li> <li>c) "GTTL"</li> <li>c) "GTTL"<td></td><td></td><td>controlled by the DP8409A and</td><td>17)</td><td>OB0</td><td>•</td></li></ul> |       |               | controlled by the DP8409A and     | 17) | OB0               | •                                    |
| <ul> <li>b) Dolly bala Direction in, from NS22016, indicates the direction of the data transfer during a bus cycle.</li> <li>a) "RFIO" Refresh request output from the DP4009A, also is used as a reset input to set PAL to a known state.</li> <li>a) "ROT" Output from PAL # 2 indicating that the NS22016 is in an access cycle.</li> <li>a) "2D" "RASIN" or "RFSH" delayed by 2 periods of FCLK. This output is may built register.</li> <li>a) "2D" "RASIN" or "RFSH" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>a) "2D" "4D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>a) "Cher Enables PAL outputs.</li> <li>a) "CRETE TH outputs.</li> <li>a) "CRETE TH outputs.</li> <li>b) "6D" "6D" "6D" "6D" and and the external shift register.</li> <li>a) "14D" "2D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>a) "14D" "2D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>a) "6D" "6D" "6D" "6D" "6D" "6D" "6D" "6D</li></ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |       |               |                                   | 16) | "DDLIEO"          |                                      |
| <ul> <li>The late the back of the sector of the back of the sector of the back of the back of the sector of the back of the ba</li></ul>                                                                                       | 4)    | "DDIN"        |                                   | 10) | FBOFO             |                                      |
| 5)       "RFIO"       Refresh frequest output from the DP409A, also is used as a reset input to set PAL to a known state.       Memory data bus.       Controls memory buffers that integrate the NS32016 is in an access cycle.         6)       "INCY"       Output from NS32016 is in an access cycle.       14)       "INCY"       Output indicating that the NS32016 is in an access cycle.         7)       "ACHEE"       "If address bit 0 and high byte enable (from NS32016 is an access cycle.       14)       "INCY"       Output indicating that any error, "AE", was valid during a READ access cycle.       14)       "INCY"       Fast clock from NS32016 is an access cycle.         9)       "ERFLAT"       Output from PAL #3 indicating that any error, "AE", was valid during a READ access cycle.       11)       "IDIAGO"       Fast clock from NS32016 is an access cycle.         11)       "OE"       Enable input from I/O port for diagnost by 2 periods of RCK, also an output of the external shift register.       3)       "DIAGO"       Fast clock from the NS32016.         12)       "GO"       "AD" delayed by 2 periods of RGK, also an output of the external shift register.       6)       "CSRASIN"       Output from I/O port to reset prot.         16)       "RESH"       Input to DP409A, causes a WRITE to Sole the below of the CSLE".       6)       "CSRASIN"         17)       "RASIN"       Input to DP409A, causes a wight to the external shift register.       6)       "CO                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |       |               |                                   |     |                   |                                      |
| <ul> <li>DPA409A, also is used as a reset input for shaft interfiace between the DRAM and the NS22016 is in an access cycle.</li> <li>"NOTO"</li> <li>"ADHEE"</li> <li>"ADHEE"<!--</td--><td>5)</td><td>"BEIO"</td><td></td><td></td><td></td><td></td></li></ul>                | 5)    | "BEIO"        |                                   |     |                   |                                      |
| <ul> <li>input to set PAL to a known state.</li> <li>input to set PAL to a known state.</li> <li>invo to set PAL to a known state.</li> <li>invo to PAL # 2 indicating that a bus.</li> <li>in an access cycle.</li> <li>in</li></ul>                                                                                       | 5)    | nFIO          | · · ·                             | 15) | "DOUTB"           | Controls memory buffers that inter-  |
| <ul> <li>6) "INCY" Output from PAL #2 indicating that the NS32016 is in an access cycle.</li> <li>7) "AOHBE" if address bit 0 and high byte enable (from NS32016 are both low this input is high. Used to determine when byte operations are in progress.</li> <li>8) "2D" "RASIN" Or "FIFSH" delayed by 2 periods of FCLK." This output from PAL #2 indicating that any error, "AC", was valid during a READ access cycle.</li> <li>9) "ERRLAT" Output from PAL #2 indicating that any error, "AC", was valid during a READ access cycle.</li> <li>11) "OE" Enables PAL outputs.</li> <li>12) "CWAIT"</li> <li>9) "ERRLAT" Output from PAL #2 indicating that any error, "AC", was valid during a READ access cycle.</li> <li>11) "OE". Enables PAL outputs.</li> <li>12) "CRSRAIN"</li> <li>14) "CP" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>15) "WIN"</li> <li>16) "RFSH"</li> <li>17) "FRSH"</li> <li>19) "BD" "GD" Hiput to DP8409A, causes the DP8409A, causes an input to the DP8409A, causes an input to the DP8409A, causes and functions as a signal that the paratous a suginal that the paratous as a signal that the paratous</li></ul>                                                                                         |       |               | -                                 |     |                   | face between the DRAM and the        |
| 14       "INCY"       Output from NS32016 is in an access cycle.         7)       "AOHBE"       14       "INCY"       Output from NS32016 is in an access cycle.         7)       "AOHBE"       11       "INCY"       Output from NS32016 is in an access cycle.         8)       "2D"       "RANN" or "RFSH" delayed by 2       "FAL # 3 Inputs       "INCY"       System Clock from NS32201.         9)       "ERRLAT"       Output from PAL # 3 indicating that an access cycle.       10       "FCK, also an output of the external shift register.       3)       "DIAGO"       System Clock from NS32201.         9)       "ERRLAT"       Output from PAL # 3 indicating that an access cycle.       4)       "DIAGO"       System Clock from NS32201.         11)       "OE"       Enable input from I/O port for diagnostic to enable "OLE", check from NS (Also an output of the external shift register.       3)       "DIAGO"       Enable input from I/O port to reset PAL error latches.         19)       "6D"       delayed by 2 periods of RGCK, also an output of the external shift register.       6)       "CSRASIN"       Output from PAL # 1 logically "NOR" ed trigent".         19)       "BD"       This totput is used as an input to the DP4409A. It causes a WRITE to the DP4409A. It causes a wait the particular access cycle.       11)       "OE"         14)       "TRSFN"       Output from PAL # 1 that indic                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | 6)    | "INCY"        | •                                 |     |                   |                                      |
| 7)       "AOHEE"       If address bit 0 and high byte enable (from NS32016 are both low rates in progress.       Is in an access cycle.       Output to NS32016 that causes WAT states to be inserted into the NS32016 that causes WAT states to be inserted into the NS32016 that causes in the external shift register.         9)       "ERRLAT"       Output to NS32016 that causes in the external shift register.       1)       "FESH"       Fast clock from NS32010.       Fast clock from NS32010.         9)       "ERRLAT"       Output torom PAL #3 indicating that any error, "AE", was valid during a READ access cycle.       1)       "ICKAT"       Fast clock from NS32010.         11)       "OE"       Enables PAL outputs.       3)       "DIAGCS"       Fast clock from IN2 port for diagnostics to enable "CLE", check bit syndrome tach enable.         12)       "4D"       "2D"       "delayed by 2 periods of FGCK, also an output of the external shift register.       6)       "CSRASIN"       Output from I/O port to reset prot laches.         18)       "6D"       "4D Utputs       6)       "CSRASIN"       Output from DP8400 indicating an error.         19)       "BD"       This site "EO" and "E1" error flags, of the DP8409A, causes the DP8409A, ta causes a WRITE to the DRAM.       8)       "EOUT"       This is the "E0" and "E1" error flags, of the DP8400A, logically "NOR" ed together.         10)       "TRESH"       Output from PAL #1 that indicates whether the DRAM. accoss cycle is midw                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | ,     |               |                                   | 14) | "INCY"            |                                      |
| <ul> <li>able from NS32016 bus cycles.</li> <li>"BAL # 1 Outputs</li> <li>"GYCLED"</li> <li>"RASIN" or "RFSH" delayed by 2</li> <li>periods of FCLK. This output is night register.</li> <li>"CTL".</li> <li>"CTL".</li> <li>"CTL".</li> <li>"CTL".</li> <li>"System clock from NS32201.</li> <li>"DIAGCS"</li> <li>"DIAGCS"</li> <li>"DIAGCS"</li> <li>"DIAGCS"</li> <li>"Bable input from N2. #3 indicating that any orror, "AE", was valid during a mit register.</li> <li>"GP"</li> <li>"GP"</li> <li>"GP"</li> <li>"AD" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"GP"</li> <li>"GP"</li></ul>                                                                                            | 7)    | "AOHBE"       |                                   | 40) |                   |                                      |
| <ul> <li>NS32016 bus cycles.</li> <li>NS2016 bus cyc</li></ul>                                                                                       |       |               |                                   | 12) | "CWAIT"           |                                      |
| <ul> <li>and the properties of the properties are in progress.</li> <li>"2D" "RASIN" or "RFSH" delayed by 2 periods of FCLK. This output from PLA #3 indicating that any error, "AE", was valid during a READ access cycle.</li> <li>any error, "AE", was valid during a READ access cycle.</li> <li>"2D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"6D" "4D" "BD" "GD" "GP" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"8D" "6D" "GP" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"8D" "6D" "GP" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"8D" "GD" "GP" and the process are interested and the the process are interested.</li> <li>"6D" "GPT" input to DP8409A (causes the DP8409A). It causes a wRITE the DP8409A. It causes a wRITE the DP8409A. It causes a wRITE the DP8409A. It causes a wWITE the the DP8400. The ata base.</li> <li>"WIN" This output from NS32016, address bit0.</li> <li>"TAST" Output from NS32016, address bit0.</li> <li>"TST" Output from NS32016, address bit0.</li> <li>"TST" Output from NS32016, address bit0.</li> <li>"TST" Output from NS32016.</li> <li>"TST" Output from NS32016.</li> <lii< td=""><td></td><td></td><td></td><td></td><td></td><td></td></lii<></ul>                       |       |               |                                   |     |                   |                                      |
| <ul> <li>8) "2D" "RASIN" or "RFSH" delayed by 2 periods of FCLK. This output is mPAL #3 indicating that any error, "AE", was valid during a READ access cycle.</li> <li>9) "ERRLAT" "OLUPUT from PAL #3 indicating that any error, "AE", was valid during a READ access cycle.</li> <li>11) "OE" Enables PAL outputs.</li> <li>12) "AD" "2D" delayed by 2 periods of RFCK, also an output of the external shift register.</li> <li>18) "GD" "4D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "BD" "GD" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "BD" "GD" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "BD" "GD" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "BD" "GD" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "BDI" "RASIN" Input to DP8409A indicating an error.</li> <li>111 "CE" This output is used as an input to the DP8409A, it causes a WRTE to the DP409A, and the DP8409A, it causes a WRTE to the DP409A, and the DP400A, it causes a WRTE to the DP40AM.</li> <li>14) "CYCLED" This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>14) "TRSH" Output from PAL #1 that indicates where the DPAMA are being refreshed.</li> <li>19) "DDIN"</li> <li>20 "FASIN" Output from NS32016, address bit0.</li> <li>3) "AO" Output from NS32016, mother bable.</li> <li>4) "TSO" Output from NS32016.</li> <li>3) "AO"</li> <li>3) "AO" Output from NS32016.</li> <li>4) "TSO" Output from NS32016.</li> <li>4) "TSO" Output from NS32016.</li> <li>5) "DDIN"</li> <li>3) "AO" Output from NS32016.</li> <li>4) "TSO" Output from RS32016.</li> <li>5) "DOIN"</li> <li>4) "CSC" Chip belect for the DRAM.</li> <li>4) "CSC" Chip belect for the DRAM.</li> <li>4) "D</li></ul>                                                                                       |       |               |                                   |     |                   | 14002010 bus cycles.                 |
| <ul> <li>9) "ERRLAT" Output from PAL #3 indicating that any error, "AE", was valid during a READ access cycle.</li> <li>11) "OE" Enables PAL outputs.</li> <li>12) "AD" "ZD" delayed by 2 periods of RFCK, also an output of the external shift register.</li> <li>18) "6D" "4D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "BD" "DOT delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "RFSH"</li> <li>10) "FRSH"</li> <li>11) "CYCLED" This is used as an input to the DP8409A. It causes a WRITE to the DRAM. are being refresh.</li> <li>14) "CYCLED" This output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>10) "RFSH"</li> <li>11) "RFSH"</li> <li>11) "RFSH"</li> <li>12) "AO"</li> <li>14) "CYCLED" This output from NS32016.</li> <li>15) "DIN"</li> <li>16) "ADN"</li> <li>17) "RASIN" Output from PAL #1.</li> <li>18) "AO"</li> <li>19) "DDIN"</li> <li>10) "ADN"</li> <li>21) "ADN"</li> <li>21) "ADN"</li> <li>21) "ADN"</li> <li>21) "ADN"</li> <li>21) "ADN"</li> <li>22) "ADN"</li> <li>23) "ADN"</li> <li>24) "DIN"</li> <li>24) "DIN"</li> <li>24) "ADR</li> <li>25) "DIN"</li> <li>26) "DIN"</li> <li>27) "TSO"</li> <li>28) "ADN"</li> <li>29) "DDIN"</li> <li>20) "DDIN"</li> <li>20) "DDIN"</li> <li>21) "ADN"</li> <li>21) "ADN"</li> <li>22) "ADN"</li> <li>23) "ADN"</li> <li>24) "ADN"</li> <li>25) "DIN"</li> <li>26) "DIN"</li> <li>27) "TSO"</li> <li>28) "ADN"</li> <li>29) "DDIN"</li> <li>29) "DDIN"</li> <li>20) "ADN"</li> <li>20) "ADN"</li> <li>20) "DDIN"</li> <li>21) "ADN"</li> <li>21) "ADN"</li> <li>22) "ADN"</li> <li>23) "ADN"</li> <li>24) "ADAN ARD HE AND HE AN</li></ul>                                                                                       | 0)    | "OD"          |                                   |     |                   |                                      |
| irom the external shift register.       3)       "DIAGGS"       Enable input from I/O port for diag-<br>nostics to enable.         9)       "ERRLAT"       August from PAL #3 indicating that<br>any error, "AE", was valid during a<br>READ access cycle.       4)       "DIAGGS"       Enable input from I/O port for diag-<br>nostics to enable.         11)       "OE"       Enables PAL outputs.       5)       "RESET"       Enable input from I/O port to reset<br>phable input from I/O port to reset         12)       "4D"       "2D" delayed by 2 periods of<br>RGCK, also an output of the exter-<br>nal shift register.       6)       "CSRASIN"       Output from PAL #1 logically<br>"NOR" eduyed by 2 periods of<br>RGCK, also an output of the exter-<br>nal shift register.         19)       "8D"       "6D"       Input to DP8409A,<br>to the DP8409A, to acuess the<br>DP8409A, to enter mode 1 to do a<br>refresh.       6)       "COTUF"       This is the "E0" and "E1" error<br>flags, of the DP8400, logically<br>"NOR" edugether.         15)       "WIN"       This output is used in many other<br>equasions and functions as a sig-<br>nal that the particular access cycle<br>is midway to completion.       11)       "OE"       Thable input from NS32016,<br>are below the DP8400,<br>to imput from PAL #1 that indicates<br>whether the DRAMs are being re-<br>freshed.       19)       "DDIN"       Output from NS32016,<br>is midway to completion.         2)       "ASIN"       Output from NS32016, high byte<br>enable.       17)       "CSEE"       Output that controls both the<br>DP8400.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | 0)    | 20            |                                   |     |                   |                                      |
| <ul> <li>9) "ERRLAT" Output from PAL #3 indicating that any error, "AE", was valid during a READ access cycle.</li> <li>11) "OE" Enables PAL outputs.</li> <li>12) "4D" "2D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>18) "6D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>10) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>10) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>10) "RFSH" Input to DP8409A causes the DP8409A to enter mode 1 to do a refresh.</li> <li>10) "WIN" This output is used as an input to the DR40A, access cycle.</li> <li>11) "CF" This output is used as an input to the DR40A, access cycle.</li> <li>11) "CF" This output is used as an input to the DR40A, access cycle.</li> <li>11) "CF" In soutput is used as an input to the DR40A, access cycle.</li> <li>11) "CF" In soutput is used as an input to the DR40A, access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>10) "This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>19) "DDIN" Data Direction in, from NS32016, address bit0.</li> <li>14) "CYCLED" There output from NS32016, address bit0.</li> <li>14) "THE" Output from NS32016, high byte enable.</li> <li>15) "DIN" Data Direction in, from NS32016.</li> <li>17) "TSO" Output from the shilt register.</li> <li>17) "TSO" Output from the shilt register.</li> <li>17) "CSE" Output there the DR4M.</li> </ul>                                                                                                             |       |               | • •                               |     |                   | •                                    |
| any error, "AE", was valid during a<br>READ access cycle.       bit syndrome latch enable.         11)       "OE"       Enables PAL outputs.         12)       "4D"       "2D" delayed by 2 periods of<br>RFCK, also an output of the exter-<br>nal shift register.       4)       "DIAGD"       Enable input from I/O port for diag-<br>nostics to enable.         18)       "6D"       "4D" delayed by 2 periods of<br>RGCK, also an output of the exter-<br>nal shift register.       6)       "CSRASIN"       Output from the PAL # 1 logically<br>"NOR" ed with the DRAM Chip Se-<br>lect signal. This indicates the be-<br>lect signal. This indicates the be-<br>ginning of a selected DRAM ac-<br>cess cycle.         19)       "8D"       "for delayed by 2 periods of<br>RGCK, also an output of the exter-<br>nal shift register.       6)       "CSRASIN"       Output from the PAL # 1 logically<br>"NOR" ed with the DRAM Chip Se-<br>lect signal. This indicates the be-<br>ginning of a selected DRAM ac-<br>cess cycle.         19)       "RFSH"       Input to DP8409A, causes the<br>DP8409A to enter mode 1 to do a<br>refresh.       6)       "EOI"       This is the "EO" and "E1" error<br>flags, of the DP8400, logically<br>"NOR" ed together.         14)       "CYCLED"       This output is used in many other<br>equasions and functions as a sign<br>mait that the particular access cycle<br>is midway to completion.       19)       "DDIN"       Thables the PAL outputs.         11)       "GEFR"       Output from NS32016, dadress bit0.       17)       "CSLE"       Output that controls both the<br>DP8400.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | 9)    | "ERRLAT"      |                                   | 3)  | DIAGUS            |                                      |
| READ access cycle.4)"DIAGD"Enable input from I/O port for diagnostics to enable input from I/O port for diagnostics to enable.11)"GP"Enables PAL outputs.enable.12)"4D""2D" delayed by 2 periods of RFCK, also an output of the external shift register.fileenable.18)"6D""4D" delayed by 2 periods of RGCK, also an output of the external shift register.filefile19)"8D""6D" delayed by 2 periods of RGCK, also an output of the external shift register.filefile19)"8D""6D" delayed by 2 periods of RGCK, also an output of the external shift register.filefile10)"8D""6D" delayed by 2 periods of RGCK, also an output of the external shift register.filefile10)"8D""6D" delayed by 2 periods of RGCK, also an output of the external shift register.filefile17)"RESH"Input to DP8409Afilefile16)"WIN"This output is used as an input to the DP8409A, ti causes a WRITE to the DP8409A. It causes a WRITE to the DR4M.filefile14)"CYCLED"This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.filefilePAL #2 Inputs0Output from NS32016, address bit 0.filefilefile1)"RESH"Output from NS32016, address bit 0.filefilefile2)"RASIN"Output from NS32016, high byte enable.filefilefile3)"AO"Output from NS32016,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | -,    |               |                                   |     |                   |                                      |
| 11)       "OE"       Enables PAL outputs.       nostics to enable "DLE", data latch enable.         12)       "4D"       "2D" delayed by 2 periods of RFCK, also an output of the external shift register.       nostics to enable.         18)       "6D"       "4D"       periods of RGCK, also an output of the external shift register.       5)       "RESET"       Reset input from I/O port to reset PAL error latches.         18)       "6D"       "GEV"       PAL #1 Outputs       6)       "CSRASIN"       Output from the PAL #1 logically "NOR" edvish the DRAM Chip Select signal. This indicates the beginning of a selected DRAM access cycle.         19)       "8D"       Input to DP8409A, causes the DP8409A to enter mode 1 to do a refresh.       7)       "AE"       Output from DP8400, logically "NOR" edvish the the PAL #1 error face between the DRAM and the DP8400, logically "NOR" edvishter.         14)       "CYCLED"       This output is used in many other erfresh.       9)       "DOUTB"       Table (from NS32016, address bit0.         1)       "RESH"       Output from PAL #1 that indicates whether the DRAMs are being refreshed.       19)       "DDIN"         2)       "RASIN"       Output from NS32016, address bit0.       17)       "CSE"       Output thor NS32016.         1)       "AD"       Output from NS32016, high byte enable.       17)       "CSE"       Output that controls both the DP8400. <tr< td=""><td></td><td></td><td></td><td>4)</td><td>"DIAGD"</td><td></td></tr<>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |       |               |                                   | 4)  | "DIAGD"           |                                      |
| <ul> <li>HECK, also an output of the external shift register.</li> <li>"6D" "40" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"6D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"6D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"6D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"6D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>"7) "RASIN"</li> <li>Input to DP8409A, causes the DP8409A to enter mode 1 to do a refresh.</li> <li>"WIN" This output is used as an input to the DP8409A. It causes a WRITE to the DP8409A. It causes a WRITE to the DP8409A. It causes a WRITE is is midway to completion.</li> <li>"WIN" This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>"RESH" Output from PAL #1 that indicates whether the DRAMs are being refresh.</li> <li>"CYCLED" The output from PAL #1 that indicates whether the DRAMs are being refresh.</li> <li>"RESH" Output from NS32016, address bit 0.</li> <li>"ADS" Address strobe from NS32016.</li> <li>"ADS" Address trobe from NS32016.</li> <li>"ADS" Address trobe from NS32016.</li> <li>"ADS" Address strobe from NS32016.</li> <li>"ADS" Address trobe from NS32016.</li> <li>"ADS" Address trobe from NS32016.</li> <li>"ADS" Ad</li></ul>                                                                                       | 11)   |               | Enables PAL outputs.              |     |                   |                                      |
| 18)       "6D"       "4D" delayed by 2 periods of<br>RGCK, also a output of the exter-<br>nal shift register.       6)       "CSRASIN"       PAL error latches.         19)       "8D"       "6D" delayed by 2 periods of<br>RGCK, also a output of the exter-<br>nal shift register.       6)       "CSRASIN"       Output from the PAL #1 logically<br>"NOR"ed with the DRAM Chip Se-<br>lect signal. This indicates the be-<br>ginning of a selected DRAM ac-<br>cess cycle.         19)       "8D"       "RESR"       Input to DP8409A       8)       "E01"       This is the "E0" and "E1" error<br>flags, of the DP8400, logically<br>"NOR"ed together.         16)       "RFSR"       Input to DP8409A, causes the<br>DP8409A to enter mode 1 to do a<br>refresh.       8)       "E01"       This is the "E0" and "E1" error<br>flags, of the DP8400, logically<br>"NOR"ed together.         15)       "WIN"       This output is used as an input to<br>the DP8409A. It causes a WRITE<br>to the DRAM.       8)       "E01"       This is the "E0" and "E1" error<br>flags, of the DP8400, logically<br>"NOR"ed together.         14)       "CYCLED"       This output is used in many other<br>equasions and functions as a sig-<br>nal that the particular access cycle<br>is midway to completion.       19)       "DDIN"       Output from NS32016, address bit0.         1)       "RFSH"       Output from NA32016, address bit0.       17)       "CSLE"       Output that controls both the<br>DP8400.         2)       "ADS"       Address strobe from NS32016.       17)       "CSL                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | 12)   | "4D"          |                                   |     |                   | enable.                              |
| <ul> <li>18) "6D" "4D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>10) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>10) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>10) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>11) "RFSH" Input to DP8409A, causes the DP8409A to enter mode 1 to do a refresh.</li> <li>15) "WIN" This output is used as an input to the DRAM.</li> <li>14) "CYCLED" This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>11) "RFSH" Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>2) "RASIN" Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>3) "AO" Output from NS32016, address bit 0.</li> <li>4) "HBE" Output from NS32016, high byte enable.</li> <li>5) "DIN" Data Direction in, from NS32016.</li> <li>6) "ADS" Address strob from NS32016.</li> <li>6) "ADS" Output from the Shift register.</li> <li>9) "CSS" Output from the DRAM.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |       |               |                                   | 5)  | "RESET"           | Reset input from I/O port to reset   |
| RGCK, also an output of the external shift register.       "NOR"ed with the DRAM Chip Select signal. This indicates the belet signal. This indicates the beginning of a selected DRAM access cycle.         19)       "8D"       "6D" delayed by 2 periods of RGCK, also an output of the external shift register.       7)       "AE"       Output from DP8400 indicating an error.         71       "FRSIN"       Input to DP8409A, causes the DP8409A, causes the DP8409A to enter mode 1 to do a refresh.       8)       "E01"       This is the "E0" and "E1" error flags, of the DP8400, logically "NOR"ed together.         15)       "WIN"       This output is used as an input to the DR4M.       9)       "DOUTB"       Controls memory buffers that interface between the DR4M and the DP8400, nemory data base.         15)       "WIN"       This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.       11)       "OE"       If address bit 0 AND high byte enable. (from NS32016, address bit0.         1)       "RFSH"       Output from PAL #1 that indicates whether the DRAMs are being refreshed.       19)       "DDIN"         1)       "RFSH"       Output from NS32016, address bit0.       17)       "CSLE"       Output that controls both the DP8400 perations in from NS32016.         14)       "HE"       Output from NS32016, high byte enable.       19)       "DDIN"       Data Direction in, from NS32016.       17)       "CSLE" <t< td=""><td>40)</td><td>"OD"</td><td></td><td></td><td></td><td></td></t<>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | 40)   | "OD"          |                                   |     |                   |                                      |
| <ul> <li>nal shift register.</li> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>70 "7ASIN" Input to DP8409A, causes the DP8409A to enter mode 1 to do a refresh.</li> <li>15) "WIN" This output is used as an input to the DP8409A, it causes a WRITE to the DRAM.</li> <li>15) "WIN" This output is used in many other equasions and functions as a signal that the particular access cycle.</li> <li>71 "GE" Inputs</li> <li>14) "CYCLED" This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>19) "DDIN" Data Direction in, from NS32016, address bit 0.</li> <li>6) "ADS" Address strobe from NS32016.</li> <li>17) "TSO" Output from NS32016.</li> <li>17) "</li></ul>                                                                                       | 16)   | 60            |                                   | 6)  | "CSRASIN"         |                                      |
| <ul> <li>19) "8D" "6D" delayed by 2 periods of RGCK, also an output of the external shift register.</li> <li>7) "RASIN" Input to DP8409A causes the DP8409A to enter mode 1 to do a refresh.</li> <li>15) "WIN" This output is used as an input to the DP8409A, tacuses a WRITE to the DP8409A, tacuses a WRITE to the DP8409A. It causes a write equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>1) "RFSH" Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>9) "DDIN"</li> <li>9) "DDIN"</li> <li>PAL #3 Output from NS32016, address bit0.</li> <li>9) "DDIN"</li> <li>Data Direction in, from NS32016.</li> <li>17) "TSO" Output from NS32016.<td></td><td></td><td></td><td></td><td></td><td>•</td></li></ul>                                    |       |               |                                   |     |                   | •                                    |
| PAL #1 Outputs       7)       "AE"       Output from DP84000 indicating an error.         17)       "RASIN"       Input to DP8409A       8)       "E01"       This is the "E0" and "E1" error flags, of the DP8400, logically "NOR"ed together.         16)       "RFSH"       Input to DP8409A, causes the DP8409A to enter mode 1 to do a refresh.       9)       "DOUTB"       Controls memory buffers that interface between the DRAM and the DP8409A. It causes a WRITE to the DRAM.       9)       "DOUTB"       Controls memory buffers that interface between the DRAM and the DP8400A, logically "NOR"ed together.         14)       "CYCLED"       This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.       11)       "OE"       Thadress bit 0 AND high byte enable. (from NS32016) are both low this input is high. Used to determine when byte operations are in progress.         1)       "RFSH"       Output from PAL #1 that indicates whether the DRAMs are being refreshed.       19)       "DDIN"       Data Direction in, from NS32016.       17)       "CSE"       Output that controls both the DP8400.         2)       "RASIN"       Output from NS32016, high byte enable.       17)       "CSE"       Output trom NS32016.       17)       "CSE"       Output that controls both the DP8400.         3)       "AO"       Output from NS32016.       17)       "CSE"       Output trom NS32016.       17)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | 19)   | "8D"          |                                   |     |                   |                                      |
| PAL #1 Outputsnal shift register.7)"AE"Output from DP8400 indicating an error.17)"RASIN"Input to DP8409A, causes the DP8409A to enter mode 1 to do a refresh.8)"E01"This is the "E0" and "E1" error flags, of the DP8400, logically "NOR"ed together.16)"WIN"This output is used as an input to the DP8409A. It causes a WRITE to the DRAM.9)"DOUTB"Controls memory buffers that interface between the DRAM and the DP8400/memory data base.15)"WIN"This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.11)"OE"If address bit 0 AND high byte enable. freshed.1)"RFSH"Output from PAL #1 that indicates whether the DRAMs are being remarked.19)"DDIN"Data Direction in, from NS32016, address bit 0.2)"RASIN"Output from NS32016, high byte enable.18)"ODLE"Output that controls both the DP8400.5)"DDIN"Data Direction in, from NS32016.17)"CSE"Output from NS32016.17)6)"ADS"Address strobe from NS32016.17)"CSE"Output from NS32016.17)6)"ADS"Address strobe from NS32016.17)"CSE"Output from the shift register.9)"CS"Chip select for the DP84M.17)"CSE"Output from NS32016.7)"TSO"Output from NS32016.17)"CSE"Output from NS32016.7)"TSO"Output from heshift register.pin of the DP8400, it is only invert-ed so the PAL programmer will pro-9) <td></td> <td></td> <td></td> <td></td> <td></td> <td></td>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |       |               |                                   |     |                   |                                      |
| PAL #1 Outputs       Input to DP8409A, causes the DP8409A, causes the DP8409A to enter mode 1 to do a refresh.       8)       "E01"       This is the "E0" and "E1" error flags, of the DP840, logically "NOR"ed together.         15)       "WIN"       This output is used as an input to the DP8409A. It causes a WRITE to the DRAM.       9)       "DOUTB"       Controls memory buffers that interface between the DRAM and the DP8400/memory data base.         14)       "CYCLED"       This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.       11)       "ODUTB"       If address bit 0 AND high byte enable (from NS32016) are both low this input is high. Used to determine when byte operations are in progress.         2)       "RASIN"       Output from PAL #1 that indicates whether the DRAMs are being refreshed.       19)       "DDIN"       Data Direction in, from NS32016, address bit 0.         2)       "RASIN"       Output from NS32016, address bit 0.       17)       "CSE"       Output from NS32016.         3)       "AO"       Output from NS32016.       17)       "CSE"       Output from NS32016.         5)       "DDIN"       Data Direction in, from NS32016.       17)       "CSE"       Output from NS32016.         6)       "ADSS"       Address strobe from NS32016.       17)       "CSE"       Output from NS32016.         7)       "TSO"       Output from the                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |       |               | nal shift register.               | 7)  | "AE"              |                                      |
| <ul> <li>17) "RASIN" Input to DP8409A</li> <li>18) "E01" This is the "E0" and "E1" error flags, of the DP8400, logically "NOR"ed together.</li> <li>15) "WIN" This output is used as an input to the DP8409A. It causes a WRITE to the DRAM.</li> <li>14) "CYCLED" This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>1) "RFSH" Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>2) "RASIN" Output from PAL #1.</li> <li>3) "AO" Output from NS32016, address bit 0.</li> <li>4) "HBE" Output from NS32016, high byte enable.</li> <li>5) "DDIN" Data Direction in, from NS32016.</li> <li>5) "DDIN" Data Direction in, from NS32016.</li> <li>6) "ADS" Address strobe from NS32016.</li> <li>6) "ADS" Address strobe from NS32016.</li> <li>6) "ADS" CS" Chip select for the DRAM.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | PAL 7 | #1 Outputs    |                                   |     |                   |                                      |
| <ul> <li>INDER to other mode 1 to do a refresh.</li> <li>"NOR"ed together.</li> <li>"NOR"ed together.</li> <li>"NOR"ed together.</li> <li>"Ontrols memory buffers that interface between the DRAM and the DP8409A. It causes a WRITE to the DRAM.</li> <li>"CYCLED"</li> <li>"This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>"PAL #2 Inputs</li> <li>"RFSH"</li> <li>Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>"AO"</li> <li>Output from PAL #1.</li> <li>"AO"</li> <li>Output from NS32016, address bit 0.</li> <li>"HBE"</li> <li>Output from NS32016, high byte enable.</li> <li>"DDIN"</li> <li>Data Direction in, from NS32016.</li> <li>"ADS"</li> <li>Address strobe from NS32016.</li> <li>"ADS"</li> <li>"ADS"</li> <li>Output from NS32016.</li> <li>"DDIN"</li> <li>This output operations are inprogrammer will pro-</li> <li>"CS"</li> <li>Chip select for the DRAM.</li> </ul>                                                                                                                                                                                                                                                                                                                                                       |       |               | Input to DP8409A                  | 8)  | "E01"             |                                      |
| <ul> <li>and the product is used as an input to the DP8409A. It causes a WRITE to the DP8409A. It causes a WRITE to the DRAM.</li> <li>(CYCLED) This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>(PAL #2 Inputs</li> <li>(TRSEH" Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>(TRASIN" Output from NA1 #1.</li> <li>(TRDE" (TRDE")</li> <li>(TRDE")</li> <li>(TRDE")&lt;</li></ul>                                                                                    | 16)   | "RFSH"        | Input to DP8409A, causes the      |     |                   |                                      |
| <ul> <li>15) "WIN" This output is used as an input to the DP8409A. It causes a WRITE to the DRAM.</li> <li>14) "CYCLED" This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>1) "RFSH" Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>2) "RASIN" Output from PAL #1.</li> <li>3) "AO" Output from PAL #1.</li> <li>3) "AO" Output from NS32016, high byte enable.</li> <li>5) "DDIN" Data Direction in, from NS32016, high byte enable.</li> <li>5) "DDIN" Data Direction in, from NS32016.</li> <li>6) "ADS" Address strobe from NS32016.</li> <li>7) "TSO" Output from NS32016.</li> <li>8) "2D" Output from the shift register.</li> <li>9) "CS" Chip select for the DRAM.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |       |               | DP8409A to enter mode 1 to do a   | -   | " <u>DOLITO</u> " | -                                    |
| Instruction       This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.       Instruction       Instructi                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |       |               |                                   | 9)  | DO018             |                                      |
| <ul> <li>to the DRAM.</li> <li>14) "CYCLED"</li> <li>14) "CYCLED"</li> <li>15 output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.</li> <li>PAL #2 Inputs</li> <li>1) "RFSH"</li> <li>Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>19) "DDIN"</li> <li>19) "DDIN"</li> <li>Data Direction in, from NS32016, address bit 0.</li> <li>11) "RFSF"</li> <li>Output from NS32016, address bit 0.</li> <li>11) "AO"</li> <li>Output from NS32016, address bit 0.</li> <li>11) "TSO"</li> <li>Output from NS32016.</li> <li>12) "ADS"</li> <li>13) "AO"</li> <li>Output from NS32016, high byte enable.</li> <li>14) "THE"</li> <li>15) "DDIN"</li> <li>16) "ODLE"</li> <li>17) "CSLE"</li> <li>Output that controls the DP8400</li> <li>Chip select for the DRAM.</li> <li>17) "CSLE"</li> <li>Enables the PAL outputs.</li> <li>11) address bit 0 AND high byte enable.</li> <li>12) "AO"</li> <li>Output from NS32016.</li> <li>17) "CSLE"</li> <li>Cutput that controls the DP8400</li> <li>Chip select for the DRAM.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | 15)   | "WIN"         |                                   |     |                   |                                      |
| 14)       "CYCLED"       This output is used in many other equasions and functions as a signal that the particular access cycle is midway to completion.       12)       "AOHBE"       If address bit 0 AND high byte enable (from NS32016) are both low this input is high. Used to determine when byte operations are in progress.         PAL #2 Inputs       0utput from PAL #1 that indicates whether the DRAMs are being refreshed.       19)       "DDIN"       Data Direction in, from NS32016.         2)       "RASIN"       Output from NS32016, address bit 0.       18)       "OUtput that controls both the DP8400 Data latch and output latches. This output goes directly to both the "DLE" and OLE pin of the DP8400.         3)       "AO"       Output from NS32016, high byte enable.       17)       "CSLE"       Output that controls the DP8400.         5)       "DDIN"       Data Direction in, from NS32016.       17)       "CSLE"       Output that controls the DP8400.         6)       "ADS"       Address strobe from NS32016.       17)       "CSLE"       Output that controls the DP8400.         7)       "TSO"       Output from the shift register.       pin of the DP8400, it is only invert-ed so the PAL programmer will pro-         9)       "CS"       Chip select for the DRAM.       ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |       |               |                                   | 11) | "OF"              |                                      |
| <ul> <li>able (from NS32016) are both low this input is high. Used to determine when byte operations are in progress.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access cycle is midway to completion.</li> <li>mai that the particular access the pa</li></ul>                                                                                       | 14)   | "CVCLED"      |                                   |     |                   |                                      |
| nal that the particular access cycle<br>is midway to completion.       this input is high. Used to deter-<br>mine when byte operations are in<br>progress.         PAL #2 Inputs       0utput from PAL #1 that indicates<br>whether the DRAMs are being re-<br>freshed.       19)       "DDIN"       Data Direction in, from NS32016.         1)       "RASIN"       Output from PAL #1.       19)       "DDE"       Output that controls both the<br>DP8400 Data latch and output<br>latches. This output goes directly to<br>both the "DLE" and OLE pin of the<br>DP8400.         2)       "RASIN"       Output from NS32016, address bit0.       18)       "OLE"       Output that controls both the<br>DP8400 Data latch and output<br>latches. This output goes directly to<br>both the "DLE" and OLE pin of the<br>DP8400.         3)       "AO"       Output from NS32016, high byte<br>enable.       17)       "CSLE"       Output that controls the DP8400<br>Check bit Syndrome latch. This<br>output goes directly to the "CSLE"         5)       "DDIN"       Data Direction in, from NS32016.       17)       "CSLE"       Output that controls the DP8400, it is only invert-<br>gin of the DP8400, it is only invert-<br>ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | 14)   | OTOLLD        |                                   | ,   |                   |                                      |
| <ul> <li>is midway to completion.</li> <li>PAL #2 Inputs         <ul> <li>"RFSH"</li> <li>Output from PAL #1 that indicates whether the DRAMs are being refreshed.</li> <li>"RASIN"</li> <li>Output from PAL #1.</li> <li>"AO"</li> <li>Output from PAL #1.</li> <li>"AO"</li> <li>Output from NS32016, address bit 0.</li> <li>"HBE"</li> <li>Output from NS32016, high byte enable.</li> <li>"DDIN"</li> <li>"DDIN"</li> <li>Data Direction in, from NS32016, high byte enable.</li> <li>"DDIN"</li> <li>TSO"</li> <li>Output from NS32016.</li> <li>"2D"</li> <li>Output from NS32016.</li> <li>"2D"</li> <li>Output from NS32016.</li> <li>"2D"</li> <li>Output from the shift register.</li> <li>"2D"</li> <li>Output from the DRAM.</li> <li>"So the PAL programmer will pro-</li> </ul> </li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |       |               |                                   |     |                   | this input is high. Used to deter-   |
| PAL #2 inputs       19       "DDIN"       Data Direction in, from NS32016.         1)       "RFSH"       Output from PAL #1 that indicates whether the DRAMs are being refreshed.       19)       "DDIN"       Data Direction in, from NS32016.         2)       "RASIN"       Output from PAL #1.       18)       "ODLE"       Output that controls both the DP8400 Data latch and output latches. This output goes directly to both the "DLE" and OLE pin of the DP8400.         3)       "AO"       Output from NS32016, high byte enable.       17)       "CSLE"       Output that controls the DP8400.         5)       "DDIN"       Data Direction in, from NS32016.       17)       "CSLE"       Output that controls the DP8400.         6)       "ADS"       Address strobe from NS32016.       17)       "CSLE"       Output that controls the DP8400.         7)       "TSO"       Output from NS32016.       17)       output goes directly to the "CSLE"         8)       "2D"       Output from the shift register.       pin of the DP8400, it is only invert-ed so the PAL programmer will pro-         9)       "CS"       Chip select for the DRAM.       ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |       |               |                                   |     |                   | mine when byte operations are in     |
| 1)       "RFSH"       Output from PAL #1 that indicates whether the DRAMs are being refreshed.       18)       Data Direction in, inon NS22010.         2)       "RASIN"       Output from PAL #1.       0utput from PAL #1.       Output from NS32016, address bit 0.         3)       "AO"       Output from NS32016, address bit 0.       18)       "ODLE"       Output that controls both the DP8400 Data latch and output latches. This output goes directly to both the "DLE" and OLE pin of the DP8400.         5)       "DDIN"       Data Direction in, from NS32016.       17)       "CSLE"       Output that controls the DP8400.         6)       "ADS"       Address strobe from NS32016.       17)       "CSLE"       Output that controls the DP8400.         6)       "ADS"       Address strobe from NS32016.       17)       "CSLE"       Output that controls the DP8400.         6)       "ADS"       Output from NS32016.       17)       output goes directly to the "CSLE"         7)       "TSO"       Output from the shift register.       pin of the DP8400, it is only invert-gister.       pin of the DP8400, it is only invert-gister.         9)       "CS"       Chip select for the DRAM.       ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |       | #2 Innute     |                                   |     |                   |                                      |
| <ul> <li>whether the DRAMs are being refreshed.</li> <li>"RASIN" Output from PAL # 1.</li> <li>"AO" Output from NS32016, address bit 0.</li> <li>"HBE" Output from NS32016, high byte enable.</li> <li>"DDIN" Data Direction in, from NS32016.</li> <li>"ADS" Address strobe from NS32016.</li> <li>"ADS" Output from NS32016.</li> <li>"DDIN" Data Direction in, from NS32016.</li> <li>"ADS" Output from NS32016.</li> <li>"CS" Output from the shift register.</li> <li>"CS" Chip select for the DRAM.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | 43    |               | Output from PAL #1 that indicates | 19) | "DDIN"            | Data Direction in, from NS32016.     |
| freshed.       18)       "ODLE"       Output that controls both the DP8400 Data latch and output         2)       "RASIN"       Output from PAL #1.       DP8400 Data latch and output         3)       "AO"       Output from NS32016, address bit 0.       latches. This output goes directly to both the "DLE" and OLE pin of the DP8400.         4)       "HBE"       Output from NS32016, high byte enable.       DP8400.         5)       "DDIN"       Data Direction in, from NS32016.       17)         6)       "ADS"       Address strobe from NS32016.       17)         6)       "ADS"       Output from NS32016.       0utput goes directly to the "CSLE"         7)       "TSO"       Output from NS32016.       output goes directly to the "CSLE"         8)       "2D"       Output from the shift register.       pin of the DP8400, it is only invert-         9)       "CS"       Chip select for the DRAM.       ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | •,    |               |                                   | PAL | #3 Outputs        |                                      |
| 3)       "AO"       Output from NS32016, address bit 0.       latches. This output goes directly to         4)       "HBE"       Output from NS32016, high byte enable.       both the "DLE" and OLE pin of the DP8400.         5)       "DDIN"       Data Direction in, from NS32016.       17)       "CSLE"       Output that controls the DP8400.         6)       "ADS"       Address strobe from NS32016.       17)       "CSLE"       Output that controls the DP8400.         7)       "TSO"       Output from NS32016.       17)       "CSLE"       output goes directly to the "CSLE"         8)       "2D"       Output from the shift register.       pin of the DP8400, it is only invert-ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |       |               |                                   | 18) | "ODLE"            |                                      |
| 4)       "HBE"       Output from NS32016, high byte enable.       both the "DLE" and OLE pin of the DP8400.         5)       "DDIN"       Data Direction in, from NS32016.       17)       "CSLE"       Output that controls the DP8400.         6)       "ADS"       Address strobe from NS32016.       17)       "CSLE"       Output that controls the DP8400.         7)       "TSO"       Output from NS32016.       0       Check bit Syndrome latch. This output goes directly to the "CSLE"         8)       "2D"       Output from the shift register.       pin of the DP8400, it is only inverted so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |       |               | Output from PAL #1.               |     |                   |                                      |
| enable.DP8400.5)"DDIN"Data Direction in, from NS32016.17)"CSLE"Output that controls the DP84006)"ADS"Address strobe from NS32016.Check bit Syndrome latch. This<br>output goes directly to the "CSLE"7)"TSO"Output from NS32016.output goes directly to the "CSLE"8)"2D"Output from the shift register.pin of the DP8400, it is only invert-<br>ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |       |               |                                   |     |                   |                                      |
| 5)"DDIN"Data Direction in, from NS32016.17)"CSLE"Output that controls the DP84006)"ADS"Address strobe from NS32016.Check bit Syndrome latch. This7)"TSO"Output from NS32016.output goes directly to the "CSLE"8)"2D"Output from the shift register.pin of the DP8400, it is only invert-9)"CS"Chip select for the DRAM.ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | 4)    | "HBE"         |                                   |     |                   |                                      |
| 6)       "ADS"       Address strobe from NS32016.       Check bit Syndrome latch. This output goes directly to the "CSLE"         7)       "TSO"       Output from NS32016.       output goes directly to the "CSLE"         8)       "2D"       Output from the shift register.       pin of the DP8400, it is only invert-         9)       "CS"       Chip select for the DRAM.       ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | 5)    | ייחחחיי       |                                   | 17) | "CSLE"            |                                      |
| 7)       "TSO"       Output from NS32016.       output goes directly to the "CSLE"         8)       "2D"       Output from the shift register.       pin of the DP8400, it is only invert-         9)       "CS"       Chip select for the DRAM.       ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |       |               |                                   | .,, | COLL              | •                                    |
| 8)     "2D"     Output from the shift register.     pin of the DP8400, it is only invert-       9)     "CS"     Chip select for the DRAM.     ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |       |               |                                   |     |                   | •                                    |
| 9) "CS" Chip select for the DRAM. ed so the PAL programmer will pro-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |       |               |                                   |     |                   |                                      |
| 11) "CYCLED" Output from PAL #1. gram it correctly.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |       |               | •                                 |     |                   |                                      |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | 11)   | "CYCLED"      | Output from PAL #1.               |     |                   | gram it correctly.                   |

13)

"ODLE"

Output Latch Enable to the

DP8400 (Output from PAL #3).

## NS32016. DP8400. DP8409A PALs Inputs and Outputs (Continued)

| DHOU, DI CHOCA I ALC II                                                             | ipato ana oatpato (continued                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | "                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|-------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| the DP8400. This signal controls<br>whether the DP8400 is in READ or<br>WRITE Mode. | DRAM ba<br>of the err<br>the DP84(<br>or triple b<br>ceding err<br>external e<br>The cont<br>displayed<br>diagnose                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | nl<br>or<br>ot<br>ro<br>er<br>o<br>w                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
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|                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
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|                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
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|                                                                                     | •                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| ASIN*/DDIN*/ERUDAI*/OD                                                              | KEAD W/GITOP                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| INCY*RASIN                                                                          | ;RFSH in idle states or in lon                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | g                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| /RFIO                                                                               | ; accesses of other devices or                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| /8D                                                                                 | ; at the beginning of an acces                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | s                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| TTL                                                                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
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| RASIN*/ERRLAT*6D*/CTTL*/DDIN                                                        | :READ w/error                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
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| •                                                                                   | ,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| • •                                                                                 | •                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                                                                     | Output that is used as an input to<br>the DP8400. This signal controls<br>whether the DP8400 is in READ or<br>WRITE Mode.<br>Used to interrupt the system when<br>a double bit error has been detect-<br>ed during a READ cycle.<br>Used in the PAL controller to indi-<br>cate that an error has occurred dur-<br>ing a CS READ cycle or a CS BYTE<br>WRITE cycle, as indicated by "AE"<br>being valid. This signal can be used<br>to latch the DRAM bank in error,<br>the SYNDROME of the error, the<br>ERROR flags, and the DRAM ad-<br>dress (of the data in error) when a<br>DRAM error occurs.<br>DIN RFIO /INCY /AOHBE 2D /EF<br>D /WIN /RFSH /RASIN 6D 8D VC<br>*/INCY*/4D*/CTTL*ERRLAT<br>*/INCY*/4D<br>RASIN*/INCY*/DDIN*/AOHBE*WIN<br>RASIN*/INCY*DDIN*/AOHBE*WIN<br>RASIN*/INCY*DDIN*/AOHBE*WIN<br>RASIN*/INCY*DDIN*/AOHBE*CTTL<br>RASIN*/DIN*/ERRLAT*/8D<br>*INCY*RASIN<br>/RFIO<br>/8D<br>CTTL<br>RASIN*/ERRLAT*6D*/CTTL*/DDIN<br>I*/RASIN*/ERRLAT*6D<br>/RASIN*/DDIN*2D*CTTL*AOHBE<br>I*/CS*/RASIN*DDIN*2D*AOHBE | the DP8400. This signal controls<br>whether the DP8400 is in READ or<br>WRITE Mode.<br>Used to interrupt the system when<br>a double bit error has been detect-<br>ed during a READ cycle.<br>Used in the PAL controller to indi-<br>cate that an error has occurred dur-<br>ing a CS READ cycle or a CS BYTE<br>WRITE cycle, as indicated by "AE"<br>being valid. This signal can be used<br>to latch the DRAM bank in error,<br>the SYNDROME of the error, the<br>ERRCR flags, and the DRAM ad-<br>dress (of the data in error) when a<br>DRAM error occurs.<br>DIN RFIO /INCY /AOHBE 2D /ERRLAT GND<br>D /WIN /RFSH /RASIN 6D 8D VCC<br>*/INCY*/4D /CTTL*ERRLAT<br>*/INCY*/4D ;WRITE or hidden RFSH<br>MASIN*/INCY*/DDIN*/6D ;READ cycle<br>MASIN*/INCY*DDIN*/AOHBE*WIN<br>*/SIN*/INCY*DDIN*/AOHBE*CTTL<br>*/RASIN*/DDIN*/ERRLAT*/8D ;READ w/error<br>*INCY*RASIN ;RFSH in idle states or in lon<br>/RFIO ; accesses of other devices or<br>/BD ; at the beginning of an access<br>TTL<br>RASIN*/ERRLAT*6D*/CTTL*/DDIN<br>*/RASIN*/ERRLAT*6D<br>*/RASIN*/DDIN*/2CTTL*AOHBE<br>*/RASIN*/DDIN*/2CTTL*AOHBE<br>*/RASIN*/ERRLAT*6D<br>*/RASIN*/ERRLAT*6D<br>*/RASIN*/ERRLAT*6D<br>*/RASIN*/ERRLAT*6D<br>*/RASIN*/ERRLAT*6D<br>*/RASIN*/ERRLAT*6D<br>*/RASIN*/DDIN*2CTTL*AOHBE<br>*/WRITE |

r r continue inue +/WIN\*RFSH\*/CS\*/RASIN\*DDIN\*/AOHBE\*6D ;BYTE WRITE continue

#### /CYCLED : =

| RFSH*/RASIN*/CS*DDIN*4D*/AOHBE*/CTTL     | BYTE WRITE               |
|------------------------------------------|--------------------------|
| + RFSH*/RASIN*/CS*DDIN*/A0HBE*4D*/CYCLED | ;BYTE WRITE              |
| +RFSH*/RASIN*/CS*/DDIN*2D*/CTTL          | :READ, READ w/error      |
| +RFSH*/RASIN*/CS*/DDIN*4D*/CYCLED        | ;READ, READ w/error      |
| +RFSH*/RASIN*/CS*DDIN*2D*A0HBE           | ;WRITE                   |
| + RFSH*/RASIN*CS*2D*/CTTL                | ;HIDDEN REFRESH          |
| + RFSH*/CYCLED*/ERRLAT                   | :Finish for READ w/error |
| + RFSH*/CYCLED*CTTL                      | ;Finish                  |

This output is used to display the DRAM bank in error, the syndrome of the error, and the error flags of the DP8400 when a single, double, or triple bit error occurs. The preceding error condition is held in an external error register (74LS374's). The contents of the registers are displayed on LED's to help the user diagnose where a DRAM problem may reside in the memory system.

# **AN-**387

#### PAL NUMBER 2

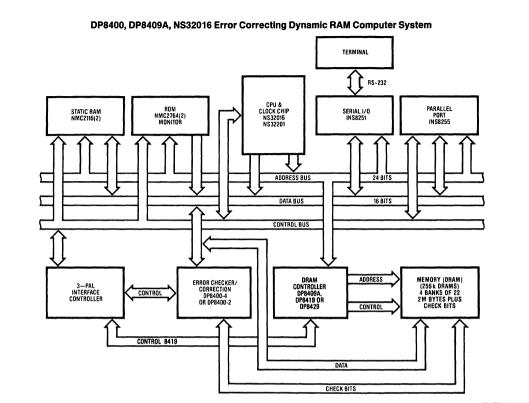
| PAL16L8A<br>/RFSH /RASIN AO /HBE /DDIN /ADS /TSO 2D /CS<br>/CYCLED /CWAIT /ODLE /INCY /DOUTB /PBUFO /C                                                                                         |                                                                                                                              |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|
| <pre>IF (VCC) /PBUF1 = RFSH*/CS*/INCY*/DDIN*2D*/HBE + RFSH*/CS*/INCY*DDIN*A0*/HBE*DOUTB*/ODLE + RFSH*/CS*/INCY*DDIN*2D*/OBO*A0*/HBE + RFSH*/CS*/INCY*DDIN*/A0*/HBE*DOUTB</pre>                 | ;READ or READ w/error<br>;*2D ;BYTE WRITE high<br>;BYTE WRITE cont<br>;word WRITE                                            |
| <pre>IF (VCC) /OB1 = RFSH*/CS*/INCY*/DDIN*2D*/CYCLED*DOUTB + RFSH*/CS*/INCY*DDIN*/AO*HBE*2D*/ODLE*DOU + RFSH*/CS*/INCY*DDIN*/AO*HBE*2D*/OB1*DOU + RFSH*/OB1*DOUTB*2D</pre>                     |                                                                                                                              |
| <pre>IF (VCC) /0B0 = RFSH*/CS*/INCY*/DDIN*2D*/CYCLED*DOUTB + RFSH*/CS*/INCY*DDIN*A0*/HBE*2D*/ODLE*DO' + RFSH*/CS*/INCY*DDIN*A0*/HBE*2D*/OB0*DOU + RFSH*/OB0*DOUTB*2D</pre>                     |                                                                                                                              |
| <pre>IF (VCC) /PEUFO =     RFSH*/CS*/INCY*/DDIN*2D*/A0     + RFSH*/CS*/INCY*DDIN*/A0*HBE*DOUTB*/ODLE*     + RFSH*/CS*/INCY*DDIN*2D*/A0*HBE*/OB1     + RFSH*/CS*/INCY*DDIN*/A0*/HBE*DOUTB</pre> | ;READ or READ w/error<br>2D ;BYTE WRITE low<br>;BYTE WRITE cont<br>;word WRITE                                               |
| <pre>IF (VCC) /DOUTB =     RFSH*/CS*/INCY*/DDIN*2D*CYCLED     + RFSH*/CS*/INCY*DDIN*/A0*HBE*2D*ODLE*0B     + RFSH*/CS*/INCY*DDIN*A0*/HBE*2D*ODLE*0B</pre>                                      |                                                                                                                              |
| <pre>IF (VCC) /INCY = RFSH*/ADS*/2D*CYCLED<br/>+ RFSH*/CS*/TSO*/2D<br/>+ RFSH*/INCY*CYCLED<br/>+ RFSH*/INCY*/TSO*/CS</pre>                                                                     | ;Start INCY<br>;Start INCY for access<br>; after forced refresh<br>; or READ w/error<br>;Continue<br>;Continue for CS access |
| <pre>IF (/CS) /CWAIT =     /RFSH*/TS0     + RFSH*/TS0*RASIN     + RFSH*/INCY*/TS0*/DDIN*/2D     + RFSH*/INCY*/TS0*DDIN*/A0*HBE*CYCLED</pre>                                                    | ;Access in RFSH<br>;Access after forced RFSH<br>;READ cycle<br>;BYTE WRITE                                                   |
| +RFSH*/INCY*/TSO*DDIN*AO*/HBE*CYCLED<br>+RFSH*/TSO*/CYCLED*/2D*RASIN                                                                                                                           | ;BYTE WRITE<br>;WAIT after READ w/error                                                                                      |

#### PAL NUMBER 3

PAL16R6A FCLK CTTL DIAGCS DIAGD /RESET CSRASIN AE EO1 /DOUTB GND /OE /AOHBE /ERROR /ERRLAT /DOUBLERR /MODECC /CSLE /ODLE /DDIN VCC /ODLE : = CSRASIN\*/DDIN\*/DOUTB\*/CTTL :Read + CSRASIN\*/DDIN\*/MODECC\*CSLE\*ODLE :Read with error + CSRASIN\*DDIN\*/AOHBE\*/DOUTB\*/CTTL :Byte Write + /ODLE\*CSRASIN\*DDIN\*/AOHBE\*CTTL :Continue during Byte Write + CSRASIN\*DDIN\*/AOHBE\*/MODECC\*CSLE\*ODLE ;Byte Write + CSRASIN\*DDIN\*AOHBE\*/CTTL ;Word Write + /ODLE\*CSRASIN\*CTTL ;Hold "/ODLE" + /ODLE\*DIAGD :Hold "/ODLE" for ; diagnostics /CSLE : = CSRASIN\*/DDIN\*/DOUTB\*/CTTL :Read + CSRASIN\*/DDIN\*/MODECC ;Read with error + CSRASIN\*DDIN\*/AOHBE\*/DOUTB\*/CTTL :Byte Write + CSRASIN\*DDIN\*/AOHBE\*/MODECC :Byte Write + CSRASIN\*DDIN\*AOHBE\*/CTTL ;Word WRITE + /CSLE\*CSRASIN\*CTTL ;Hold "/CSLE" + /CSLE\*DIAGCS ;Hold "/CSLE" for ; diagnostics /MODECC := CSRASIN\*/ODLE\*/DDIN\*/CTTL ;READ or Write w/error + CSRASIN\*/ODLE\*DDIN\*/AOHBE\*/CTTL ;BYTE WRITE + CSRASIN\*DDIN\*AOHBE :WORD WRITE + /MODECC\*CSRASIN ;Hold "/MODECC" /DOUBLERR := /DIAGCS\*/DIAGD\*RESET\*CSRASIN\*/ODLE\*/CTTL\*AE\*E01 ;Double bit error ; during READs ; or BYTE WRITES + /DOUBLERR\*RESET :Hold "/DOUBLERR" /ERRLAT := /DIAGCS\*/DIAGD\*CSRASIN\*/ODLE\*/CTTL\*AE Any Error during ; READ or BYTE WRITE + /ERRLAT\*CSRASIN :Continue "/ERRLAT" during : READ or during BYTE WRITE /ERROR := /DIAGD\*/DIAGCS\*RESET\*CSRASIN\*/ERRLAT ;Store error syndrome ; and RAS bank and ; error flags + /ERROR\*RESET ;Hold until RESET :The output, "/CSLE", is shown inverted so the PAL will be ;programmed correctly, in other words, "/CSLE" goes low after the ;rising edge of FCLK given that one of its input equations was

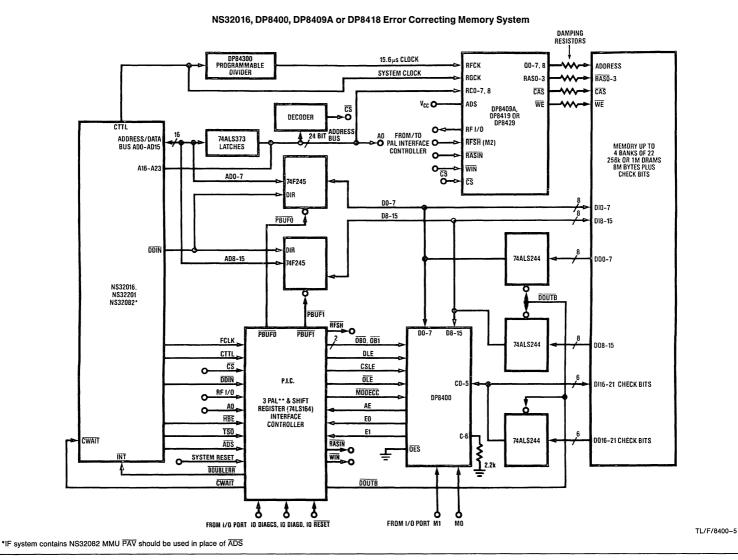
;low a setup time before FCLK transitioned high. The output, ;"/CSLE", should go straight to the pin "CSLE" of the DP8400.

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TL/F/8400-4

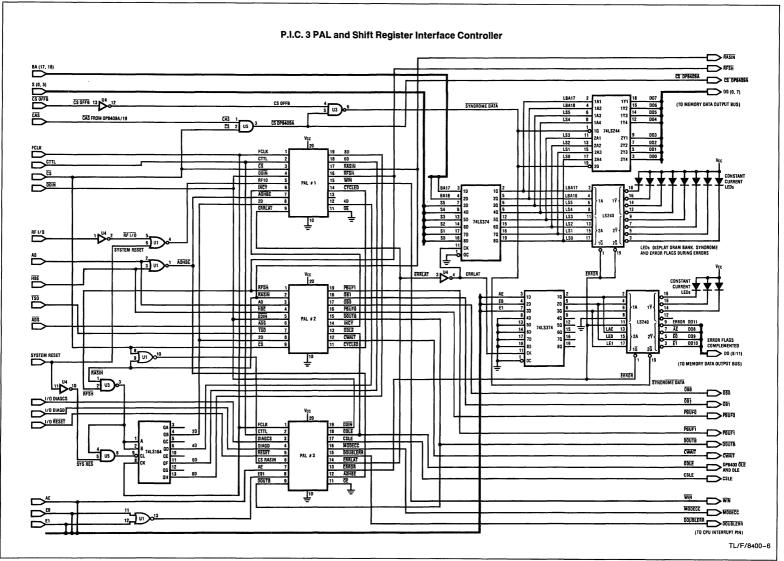


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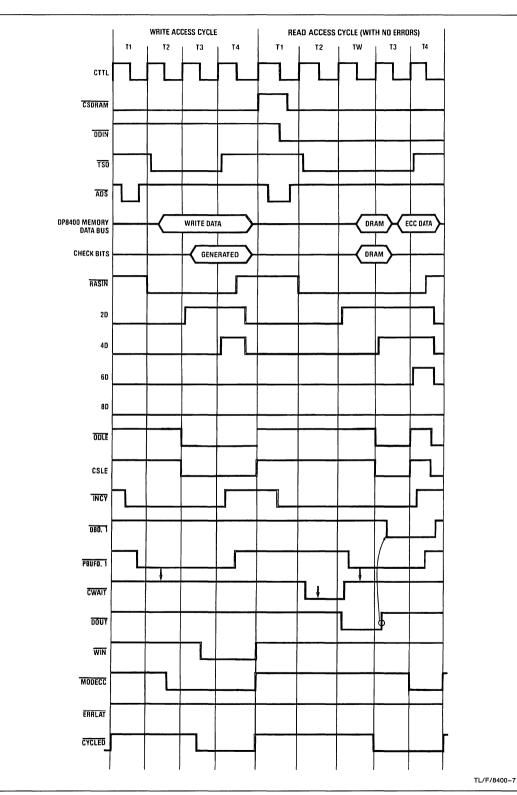
3-115

785-NA



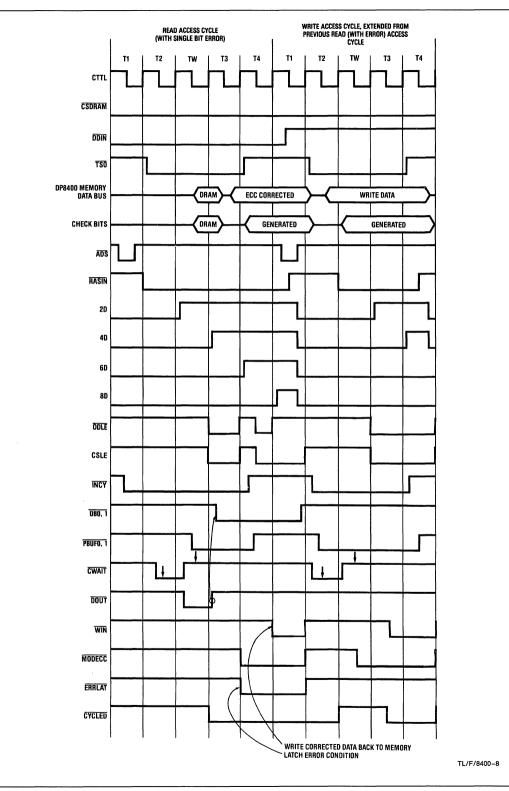


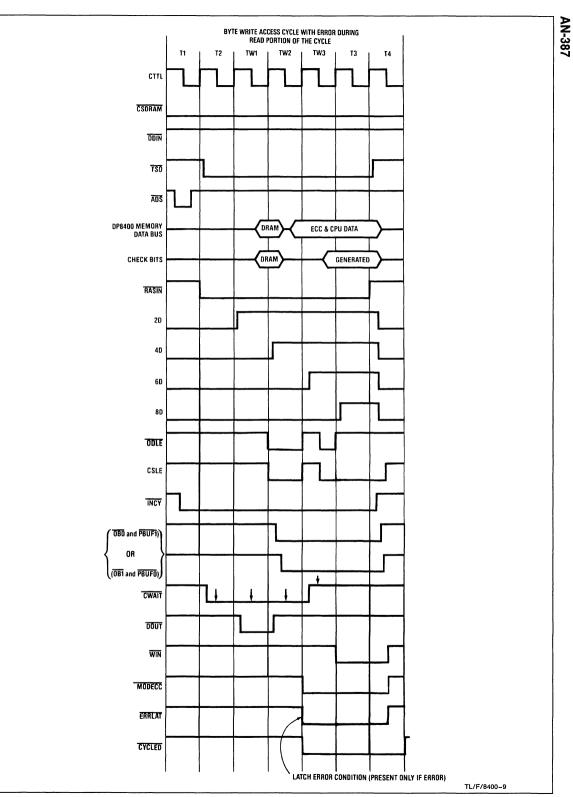
3-116



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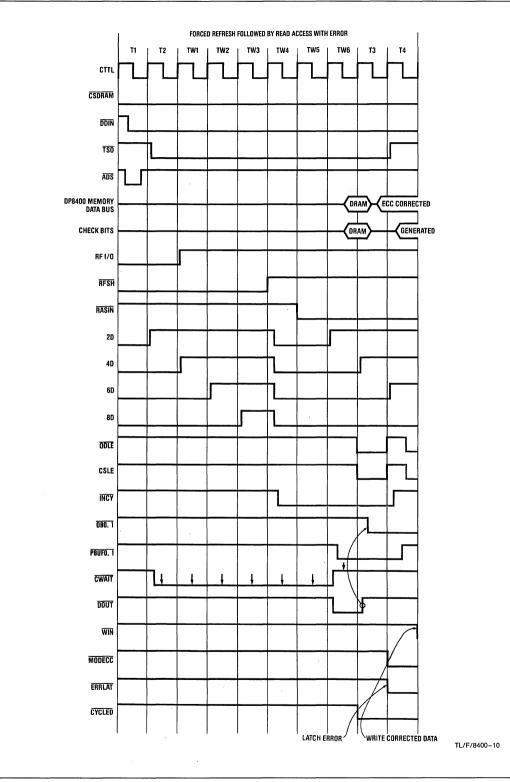
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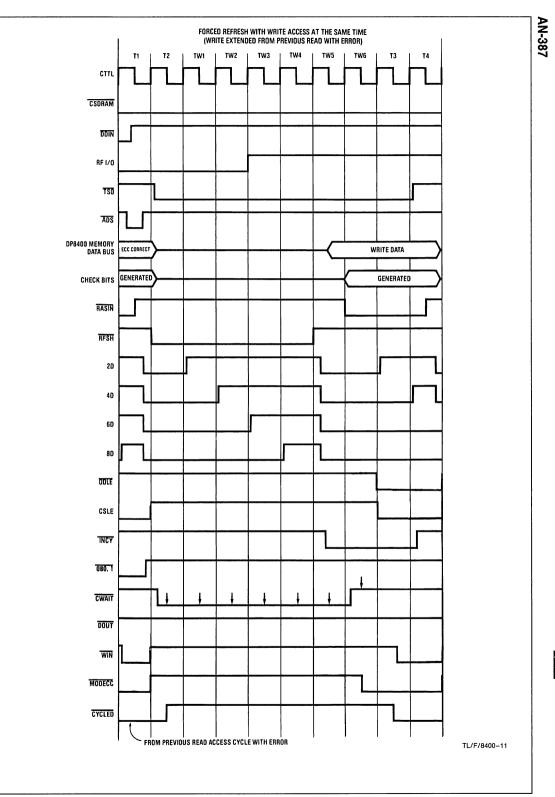




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## Determining the Speed of the Dynamic RAM Needed When Interfacing the DP8419-80 to Most Major Microprocessors

## INTRODUCTION

This application note looks at the individual delay elements of a CPU to memory access path for a typical memory system utilizing the DP8419-80 DRAM controller. In the final analysis the reader should be equipped with all the necessary equations to easily calculate the slowest/cheapest allowable DRAMS for no wait state CPU operation when using the DP8419-80 in his/her system.

Equations for calculating the maximum allowable DRAM "tRAC" (RAS access time) and "tCAC" (CAS access time) specifications for a particular microprocessor to operate at its maximum clock frequency without wait states are provided. Table I and *Figure 3* at the end of this application note give potential DP8419-80 users an illustration of what speed DRAM they may typically need to use in order to achieve no wait state operation with a particular microprocessor. It is important to note that even better performance can be achieved by using the faster DP8419-70.

### THE 5 FUNCTIONAL BLOCKS

\**Figure 1* illustrates the five functional blocks and the five main delay segments of our DP8419-80 based system example. For this particular example, the following functional block descriptions apply:

#### Functional

Block A) Functional Block Description

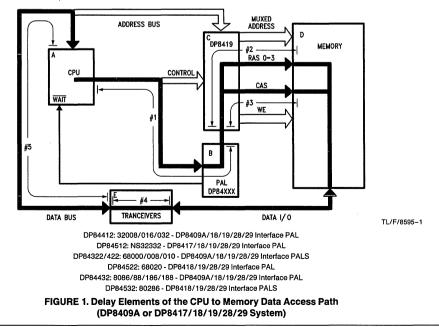
The CPU issues an access request to the PAL then reads or writes data to or from the DRAMs;

National Semiconductor Application Note 411 Webster (Rusty) Meier Jr.



Functional **Functional Block Description** Block The PAL provides the refresh access B) arbitration logic which holds off a CPU access during a DRAM refresh and DRAM refresh during a CPU access. The PAL also provides the RASIN signal to the DP8419-80; The DP8419-80 generates the control C) signal timing required by the DRAMs. It also automatically multiplexes the row and column addresses during access, provides the refresh address during refresh and provides the on board capacitive drive for the direct interface with the DRAM array: The DRAM provides or stores data in D) response to the DP8419-80's control signal: and. E) The tranceivers isolate the DRAMs from the data bus when they are not being

the data bus when they are not being accessed in addition to passing data between the CPU and memory during read and write cycles.



### DELAY SEGMENTS

Delay segments #1 through #5 are also shown in *Figure 1*. Delay segment #1 represents the timing delay from when the CPU initiates an access to the point where  $\overrightarrow{\text{RASIN}}$  is issued by the PAL to the DP8419-80;

Delay segment #2 represents the RASIN to RAS out delay of the DP8419-80 DRAM controller;

Delay segment #3 represents the RASIN to CAS out delay of the DP8419-80 DRAM controller;

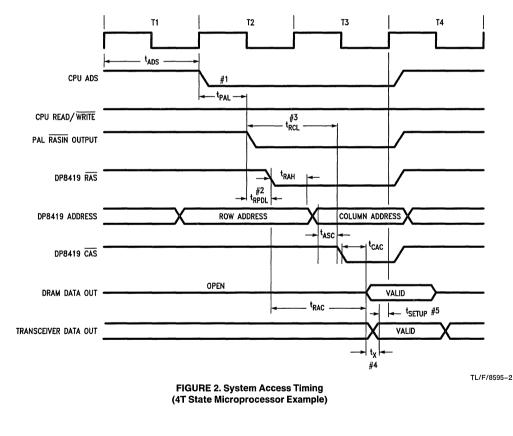
Delay segment #4 represents the inherent delay of the CPU/memory bus transceivers;

Delay segment #5 represents the required CPU data setup time.

The unique equations for determining the values of delay segments #1 through #5 for each of the major microprocessors are provided as the primary content of this application note.

Both "tRAC" and "tCAC" must be considered in determining what speed DRAM can be used in a particular system design. The DRAM chosen must meet both the "tRAC" and "tCAC" parameters calculated. If more information is desired on how "tRAC" and "tCAC" were calculated for a particular microprocessor, the reader should consult the microprocessor data sheet and the PAL data sheet for the particular microprocessor (ie. DP84412 Series 32000 processors, DP84422 68000 family processors. DP84522 68020 family processors, DP84432 iAPX88/86/188/186 processor, DP84532 iAPX286).

Most of the calculations contained in this application note use "RAHS" = 1 (15 ns guaranteed minimum row address hold time). Calculations only used "RAHS" = 0 (25 ns guaranteed minimum row address hold time) when the calculated access time from RAS equaled or exceeded 200 ns. This is because DRAMs can be found with RAS access times up to 150 ns that require only 15 ns row address hold times.



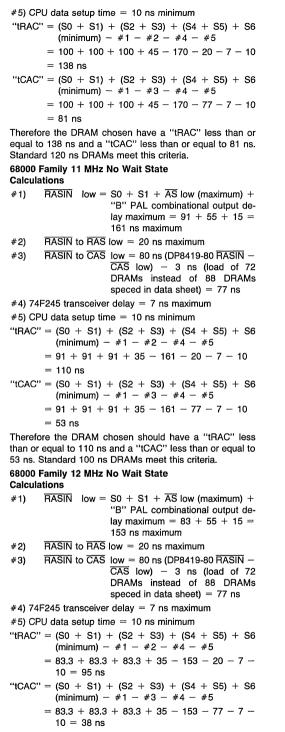
|                  | TCAC CALCULATIONS FOR THE MAJOR                                                                                                                       |
|------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|
| I) Serie         | es 32000 "tRAC" and "tCAC" Calculations                                                                                                               |
| Series           | 32000 8 MHz No Wait State Calculations                                                                                                                |
| #1)              | RASIN         Iow = T1 - 2 ns (FCLK - PHI1 skew) +<br>12 ns ("B" PAL clocked output) =<br>125 - 2 + 12 = 135 ns maximum                               |
| #2)              | <b>RASIN</b> to <b>RAS</b> low = 20 ns maximum                                                                                                        |
| #3)              | RASIN to CASlow = 80 ns (DP8419-80 RASIN -<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMs<br>speced in data sheet) = 77 ns               |
|                  | 4F245 transceiver delay = 7 ns maximum                                                                                                                |
| #5) Cl           | PU data setup time to "T4" = 20 ns minimum                                                                                                            |
| "tRAC            | " = $T1 + T2 + T3 - #1 - #2 - #4 - #5$                                                                                                                |
|                  | = 25 + 125 + 125 - 135 - 20 - 7 - 20<br>= 193 ns                                                                                                      |
| "tCAC            | " = T1 + T2 + T3 - #1 - #3 - #4 - #5                                                                                                                  |
|                  | = 125 + 125 + 125 - 135 - 77 - 7 - 20                                                                                                                 |
|                  | = 136 ns                                                                                                                                              |
| than o<br>136 ns | ore the DRAM chosen should have a "tRAC" less<br>r equal to 193 ns and a "tCAC" less than or equal to<br>s. Standard 150 ns DRAMs meet this criteria. |
|                  | 32000 10 MHz No Wait State Calculations                                                                                                               |
| #1)              | RASIN         low = T1 - 2 ns (FCLK - PHI1 skew) +<br>12 ns ("B" PAL clocked (output) =<br>100 - 2 + 12 = 110 ns maximum                              |
| #2)              | $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ low = 20 ns maximum                                                                              |
| #3)              | RASIN to CASlow = 80 ns (DP8419RASIN -CASlow) - 3 ns (load of 72DRAMsinstead of 88DRAMsspeced in data sheet) = 77 ns                                  |
| #4) 74           | 4F245 transceiver delay = 7 ns maximum                                                                                                                |
| #5) Cl           | PU data setup time to "T4" = $15 \text{ ns minimum}$                                                                                                  |
| "tRAC            | T = T1 + T2 + T3 - #1 - #2 - #4 - #5                                                                                                                  |
|                  | = 100 + 100 + 100 - 110 - 20 - 7 - 15                                                                                                                 |
|                  | = 148 ns                                                                                                                                              |
| "tCAC            | " = T1 + T2 + T3 - #1 - #3 - #4 - #5                                                                                                                  |
|                  | = 100 + 100 + 100 - 100 - 77 - 7 - 15                                                                                                                 |
|                  | = 91 ns                                                                                                                                               |
| than o           | ore the DRAM chosen should have a "tRAC" less<br>r equal to 148 ns and a "tCAC" less than or equal to<br>Standard 120 ns DRAMs meet this criteria.    |
| II) 680          | 00 Family "tRAC" and "tCAC" Calculations                                                                                                              |
| 68000            | Family 8 MHz No Wait State Calculations                                                                                                               |
| #1)              | RASINIow = S0 + S1 + AS low (maximum) +<br>"B" PAL combinational output de-<br>lay maximum = 125 + 60 + 15 =<br>200 ns maximum                        |
| #2)              | $\overline{\text{BASIN}}$ to $\overline{\text{BAS}}$ low = 20 ns maximum                                                                              |

#2)  $\overline{RASIN}$  to  $\overline{RAS}$  low = 20 ns maximum

| #3) RASIN to CAS low = 80 ns (DP8419-80 RASIN –<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 ns                            |  |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| #4) 74F245 transceiver delay = 7 ns maximum                                                                                                                             |  |
| #5) CPU data setup time = 15 ns minimum                                                                                                                                 |  |
| "tRAC" = $(S0 + S1) + (S2 + S3) + (S4 + S5) + S6$                                                                                                                       |  |
| (minimum) - #1 - #2 - #4 - #5                                                                                                                                           |  |
| = 125 + 125 + 125 + 55 - 200 - 20 - 7 - 15                                                                                                                              |  |
| = 188 ns                                                                                                                                                                |  |
| "tCAC" = (S0 + S1) + (S2 + S3) + (S4 + S5) + S6<br>(minimum) - #1 - #3 - #4 - #5                                                                                        |  |
| = 125 + 125 + 125 + 55 - 200 - 77 - 7 - 15                                                                                                                              |  |
| = 131 ns                                                                                                                                                                |  |
| Therefore the DRAM chosen should have a "tRAC" less<br>than or equal to 188 ns and a "tCAC" less than or equal to<br>131 ns. Standard 150 ns DRAMs meet this critieria. |  |
| 68000 Family 9 MHz No Wait State Calculations                                                                                                                           |  |
| <ul> <li>#1) RASIN low = S0 + S1 + AS low (maximum) +<br/>"B" PAL combinational output de-<br/>lay maximum = 111 + 55 + 15 =<br/>181 ns maximum</li> </ul>              |  |
| #2) $\overrightarrow{RASIN}$ to $\overrightarrow{RAS}$ low = 20 ns maximum                                                                                              |  |
| #3) RASIN to CAS low = 80 ns (DP8419-80 RASIN –<br>CAS low) – 3 ns (load of 72<br>DRAMs instead of 88 DRAMs<br>speced in data sheet) = 77 ns                            |  |
| #4) 74F245 transceiver delay = 7 ns maximum                                                                                                                             |  |
| #5) CPU data setup time $=$ 10 ns minimum                                                                                                                               |  |
| "tRAC" = $(S0 + S1) + (S2 + S3) + (S4 + S5) + S6$<br>(minimum) - #1 - #2 - #4 - #5                                                                                      |  |
| = 111 + 111 + 111 + 45 - 181 - 20 - 7 - 10                                                                                                                              |  |
| = 160 ns                                                                                                                                                                |  |
| "tCAC" = $(S0 + S1) + (S2 + S3) + (S4 + S5) + S6$<br>(minimum) - #1 - #3 - #4 - #5                                                                                      |  |
| = 111 + 111 + 111 + 45 - 181 - 77 - 7 - 10                                                                                                                              |  |
| = 103 ns                                                                                                                                                                |  |
| Therefore the DRAM chosen should have a "tRAC" less<br>than or equal to 160 ns and a "tCAC" less than or equal to<br>103 ns. Standard 150 ns DRAMs meet this criteria.  |  |
| 68000 Family 10 MHz No Wait State                                                                                                                                       |  |
| Calculations                                                                                                                                                            |  |
| #1) $\overline{BASIN}$ low = S0 + S1 + $\overline{AS}$ low (maximum) +                                                                                                  |  |

| #1) | $\overrightarrow{\text{RASIN}}  \text{low} = \text{S0} + \text{S1} + \overrightarrow{\text{AS}} \text{ low (maximum)} + \\ \text{``B'' PAL combinational output de-}$ |
|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|     | lay = 100 + 55                                                                                                                                                        |
|     | + 15 = 170 ns maximum                                                                                                                                                 |
| #2) | $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ low = 20 ns maximum                                                                                              |
| #3) | $\overline{\text{RASIN}}$ to $\overline{\text{CAS}}$ low = 80 ns (DP8419-80 $\overline{\text{RASIN}}$ -                                                               |
|     | CAS low) – 3 ns (load of 72                                                                                                                                           |
|     | DRAMs instead of 88 DRAMs                                                                                                                                             |

speced in data sheet) = 77 ns #4) 74F245 transceiver delay = 7 ns maximum



Therefore the DRAM chosen should have a "tRAC" less than or equal to 95 ns and a "tCAC" less than or equal to 38 ns.

#### III) 68020 "TRAC" AND "TCAC" Calculations 68020 6 MHz No Wait State Calculations

$$\overline{\text{RASIN}}$$
 to  $\overline{\text{RAS}}$  low = 20 ns maximum

#2)  $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  low = 80 ns (DP8419-80  $\overline{\text{RASIN}}$  -#3) CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMS speced in data sheet) = 77 ns

#4) 74F244 transceiver delay = 7 ns maximum

#5) CPU data setup time = 10 ns minimum

"tCAC" = (S0 + S1) + (S2 + S3) + S4 (minimum) - #1 - #3 - #4 - #5

$$= 167 + 167 + 75 - 182 - 77 - 7 - 10 = 133$$
 ns

Therefore the DRAM chosen should have a "tRAC" less than or equal to 190 ns and a "tCAC" less than or equal to 133 ns. Standard 150 ns DRAMs meet this criteria.

## 68020 7 MHz No Wait State Calculations

| #1) | <b>RASIN</b> low = S0 + S1 + "B" PAL combination-                        |
|-----|--------------------------------------------------------------------------|
|     | al output delay maximum = $143 +$                                        |
|     | 15 = 158 ns maximum                                                      |
| #2) | $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ low = 20 ns maximum |

$$\overline{\text{RASIN}}$$
 to  $\overline{\text{RAS}}$  low = 20 ns maximum

#4) 74F244 transceiver delay = 7 ns maximum

#5) CPU data setup time = 10 ns minimum

$$= 143 + 143 + 60 - 158 - 20 - 7 - 10 = 151 \text{ ns}$$

"tCAC" = (S0 + S1) + (S2 + S3) + S4 (minimum) - #1 - #3 - #4 - #5

= 143 + 143 + 60 - 158 - 77 - 7 - 10 = 94 ns

Therefore the DRAM chosen should have a "tRAC" less than or equal to 151 ns and a "tCAC" less than or equal to 94 ns. Standard 150 ns DRAMs meet this criteria.

### 68020 8 MHz No Wait State Calculations

**RASIN** low = S0 + S1 + "B" PAL combination-#1) al output delay maximum = 125 + 15 = 140 ns maximum

#2) 
$$\overline{\text{RASIN}}$$
 to  $\overline{\text{RAS}}$  low = 20 ns maximum

#3) 
$$\overrightarrow{RASIN}$$
 to  $\overrightarrow{CAS}$  low = 80 ns (DP8419-80  $\overrightarrow{RASIN}$  -

CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMS

```
speced in data sheet) = 77 ns
                    m
```

#5) CPU data setup time = 10 ns minimum

= 125 + 125 + 55 - 140 - 20 - 7 - 10 = 128 ns

| "tCAC"                                                                                                                   | = (S0 + S1) + (S2 + S3) + S4 (minimum) - #1<br>- #3 - #4 - #5                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|--------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                                                                                          | = 125 + 125 + 55 - 140 - 77 - 7 - 10 = 71 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| than or                                                                                                                  | re the DRAM chosen should have a "tRAC" less<br>equal to 128 ns and a "tCAC" less than or equal to<br>Standard 120 ns DRAMs meet this criteria.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|                                                                                                                          | 9 MHz No Wait State Calculations                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|                                                                                                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| #1)                                                                                                                      | RASINIow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 111 +<br>15 = 131 ns maximum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| #2)                                                                                                                      | <b>RASIN</b> to <b>RAS</b> low = 20 ns maximum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| #3)                                                                                                                      | RASIN to CAS       low = 80 ns (DP8419-80 RASIN -         CAS       low) - 3 ns (load of 72         DRAMs       instead of 88 DRAMS         speced in data sheet) = 77 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| #4) 74                                                                                                                   | F244 transceiver delay = 7 ns maximum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| #5) CP                                                                                                                   | U data setup time = 10 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| "tRAC"                                                                                                                   | f = (S0 + S1) + (S2 + S3) + S4 (minimum) - #1 - #2 - #4 - #5                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|                                                                                                                          | = 111 + 111 + 50 - 131 - 20 - 7 - 10<br>= 104 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| "tCAC"                                                                                                                   | <sup>2</sup> = (S0 + S1) + (S2 + S3) + S4 (minimum) − #1<br>− #3 − #4 − #5                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                                                                                                          | = 111+ 111 + 50 - 131 - 77 - 7 - 10                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|                                                                                                                          | = 47 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|                                                                                                                          | re the DRAM chosen should have a "tRAC" less equal to 104 ns and a "tCAC" less than or equal to                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| IV) 680                                                                                                                  | 20 with 1 Wait State Inserted "tRAC" and "tCAC"                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| Calcula                                                                                                                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|                                                                                                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|                                                                                                                          | Itions10 MHz (1 Wait State) Calculations $\overline{\text{RASIN}}$ low = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 68020<br>#1)                                                                                                             | 10 MHz (1 Wait State) Calculations         RASIN       Iow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| <b>68020</b><br>#1)<br>#2)                                                                                               | Itions<br>10 MHz (1 Wait State) Calculations<br>RASIN low = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum<br>RASIN to RAS low = 20 ns maximum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 68020<br>#1)                                                                                                             | 10 MHz (1 Wait State) Calculations         RASIN       Iow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 68020 7<br>#1)<br>#2)<br>#3)                                                                                             | 10 MHz (1 Wait State) Calculations         10 MHz (1 Wait State) Calculations         RASIN low = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum         RASIN to RAS low = 20 ns maximum         RASIN to CAS low = 80 ns (DP8419-80 RASIN -<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMS                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 68020 7<br>#1)<br>#2)<br>#3)<br>#4) 74                                                                                   | $\label{eq:state} \begin{array}{l} \mbox{10 MHz (1 Wait State) Calculations} \\ \hline \end{tabular} \hline tab$ |
| 68020 #<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF                                                                         | attions10 MHz (1 Wait State) Calculations $\overline{\text{RASIN}}$ low = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ low = 20 ns maximum $\overline{\text{RASIN}}$ to $\overline{\text{RAS}}$ low = 20 ns maximum $\overline{\text{RASIN}}$ to CAS low = 80 ns (DP8419-80 $\overline{\text{RASIN}}$ -<br>$\overline{\text{CAS}}$ low) - 3 ns (load of 72<br>$\overline{\text{DRAMs}}$ instead of 88 $\overline{\text{DRAMS}}$<br>speced in data sheet) = 77 nsF244 transceiver delay = 7 ns maximum $\overline{\text{U}}$ data setup time = 10 ns minimum                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 68020 #<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF                                                                         | attions10 MHz (1 Wait State) CalculationsTASINIow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximumTASIN to TAS Iow = 20 ns maximumTASIN to TAS Iow = 20 ns maximumTASIN to CAS Iow = 80 ns (DP8419-80 TASIN -<br>CAS Iow) - 3 ns (Ioad of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 nsF244 transceiver delay = 7 ns maximumU data setup time = 10 ns minimum $t = (S0 + S1) + (S2 + S3) + (SW + SW) + S4$<br>(minimum) - $#1 - #2 - #4 - #5$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 68020 #<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF                                                                         | attions10 MHz (1 Wait State) CalculationsRASINlow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximumRASIN to RAS low = 20 ns maximumRASIN to CASlow = 20 ns maximumRASIN to CASlow = 80 ns (DP8419-80 RASIN -<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 nsF244 transceiver delay = 7 ns maximumU data setup time = 10 ns minimum<br>$t = (S0 + S1) + (S2 + S3) + (SW + SW) + S4$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 68020 #<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF<br>"tRAC"                                                               | attions10 MHz (1 Wait State) CalculationsTASINIow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximumTASIN to TAS Iow = 20 ns maximumTASIN to TAS Iow = 20 ns maximumTASIN to CAS Iow = 80 ns (DP8419-80 TASIN -<br>CAS Iow) - 3 ns (Ioad of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 nsF244 transceiver delay = 7 ns maximumU data setup time = 10 ns minimum $t = (S0 + S1) + (S2 + S3) + (SW + SW) + S4$<br>(minimum) - $#1 - #2 - #4 - #5$<br>= 100 + 100 + 100 + 45 - 115 - 20 - 7 - 10                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 68020 #<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF<br>"tRAC"                                                               | Autions         10 MHz (1 Wait State) Calculations         RASIN       low = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum         RASIN to RAS low = 20 ns maximum         RASIN to RAS low = 20 ns maximum         RASIN to RAS low = 20 ns maximum         RASIN to CAS       low = 80 ns (DP8419-80 RASIN -<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 ns         F244 transceiver delay = 7 ns maximum         U data setup time = 10 ns minimum         U data setup time = 10 ns the setup time = 100 + 100 + 45 - 115 - 20 - 7 - 10         U data setup time = 10 ns time = 10 ns the setup time = 10 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 68020<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF<br>"tRAC"<br>"tCAC"<br>Therefor<br>than or<br>136 ns.                     | Attions<br>10 MHz (1 Wait State) Calculations<br>RASIN low = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum<br>RASIN to RAS low = 20 ns maximum<br>RASIN to CAS low = 80 ns (DP8419-80 RASIN -<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 ns<br>F244 transceiver delay = 7 ns maximum<br>U data setup time = 10 ns minimum<br>f = (S0 + S1) + (S2 + S3) + (SW + SW) + S4<br>(minimum) - #1 - #2 - #4 - #5<br>= 100 + 100 + 100 + 45 - 115 - 20 - 7 - 10<br>= 193 ns<br>f = (S0 + S1) + (S2 + S3) + (SW + SW) + S4<br>(minimum) - #1 - #3 - #4 - #5<br>= 100 + 100 + 100 + 45 - 115 - 77 - 7 - 10<br>= 136 ns<br>the DRAM chosen should have a "tRAC" less<br>equal to 193 ns and a "tCAC" less than or equal to<br>Standard 150 ns DRAMs meet this criteria.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 68020<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF<br>"tRAC"<br>"tRAC"<br>"tCAC"<br>Therefore<br>than or<br>136 ns.<br>68020 | Attions10 MHz (1 Wait State) CalculationsTASINlow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximumTASINlow = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximumTASIN to TAS low = 20 ns maximumTASIN to TAS low = 20 ns maximumTASIN to CASlow = 80 ns (DP8419-80 TASIN -<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 nsF244 transceiver delay = 7 ns maximumU data setup time = 10 ns minimum'= (S0 + S1) + (S2 + S3) + (SW + SW) + S4<br>(minimum) - #1 - #2 - #4 - #5= 100 + 100 + 100 + 45 - 115 - 20 - 7 - 10= 193 ns'= (S0 + S1) + (S2 + S3) + (SW + SW) + S4<br>(minimum) - #1 - #3 - #4 - #5= 100 + 100 + 100 + 45 - 115 - 77 - 7 - 10= 136 nsore the DRAM chosen should have a "tRAC" less<br>equal to 193 ns and a "tCAC" less than or equal to<br>Standard 150 ns DRAMs meet this criteria.12 MHz (1 Wait State) Calculations                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 68020<br>#1)<br>#2)<br>#3)<br>#4) 74<br>#5) CF<br>"tRAC"<br>"tCAC"<br>Therefor<br>than or<br>136 ns.                     | Attions<br>10 MHz (1 Wait State) Calculations<br>RASIN low = S0 + S1 + "B" PAL combination-<br>al output delay maximum = 100 +<br>15 = 115 ns maximum<br>RASIN to RAS low = 20 ns maximum<br>RASIN to CAS low = 80 ns (DP8419-80 RASIN -<br>CAS low) - 3 ns (load of 72<br>DRAMs instead of 88 DRAMS<br>speced in data sheet) = 77 ns<br>F244 transceiver delay = 7 ns maximum<br>U data setup time = 10 ns minimum<br>f = (S0 + S1) + (S2 + S3) + (SW + SW) + S4<br>(minimum) - #1 - #2 - #4 - #5<br>= 100 + 100 + 100 + 45 - 115 - 20 - 7 - 10<br>= 193 ns<br>f = (S0 + S1) + (S2 + S3) + (SW + SW) + S4<br>(minimum) - #1 - #3 - #4 - #5<br>= 100 + 100 + 100 + 45 - 115 - 77 - 7 - 10<br>= 136 ns<br>the DRAM chosen should have a "tRAC" less<br>equal to 193 ns and a "tCAC" less than or equal to<br>Standard 150 ns DRAMs meet this criteria.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |

**RASIN** to **RAS** low = 20 ns maximum #2) #3)  $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  low = 80 ns (DP8419-80  $\overline{\text{RASIN}}$  -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMS speced in data sheet) = 77 ns #4) 74F244 transceiver delay = 7 ns maximum #5) CPU data setup time = 10 ns minimum "tRAC" = (S0 + S1) + (S2 + S3) + (SW + SW) + S4(minimum) - #1 - #2 - #4 - #5 = 83.3 + 83.3 + 83.3 + 35 - 95 - 20 - 7 - 10= 153 ns "tCAC" = (S0 + S1) + (S2 + S3) + (SW + SW) + S4(minimum) - #1 - #3 - #4 - #5= 83.3 + 83.3 + 83.3 + 35 - 95 - 77 - 7 - 10= 96 ns Therefore the DRAM chosen should have a "tRAC" less than or equal to 153 ns and a "tCAC" less than or equal to 96 ns. Standard 150 ns DRAMs meet this criteria. 68020 14 MHz (1 Wait State) Calculations **RASIN** low = S0 + S1 + "B" PAL combination-#1) al output delay maximum = 72 +15 = 87 ns maximum #2) **RASIN** to **RAS** low = 20 ns maximum RASIN to CAS low = 80 ns (DP8419-80 RASIN -#3) CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns #4) 74F244 transceiver delay = 7 ns maximum #5) CPU data setup time = 5 ns minimum "tRAC" = (S0 + S1) + (S2 + S3) + (SW + SW) + S4 (minimum) - #1 - #2 - #4 - #5 = 72 + 72 + 72 + 30 - 87 - 20 - 7 - 5= 127 ns "tCAC" = (S0 + S1) + (S2 + S3) + (SW + SW) + S4(minimum) - #1 - #3 - #4 - #5 = 72 + 72 + 72 + 30 - 87 - 77 - 7 - 5= 70 ns Therefore the DRAM chosen should have a "tRAC" less than or equal to 127 ns and a "tCAC" less than or equal to 70 ns. Standard 120 ns DRAMs meet this criteria. 68020 16 MHz (1 Wait State) Calculations #1) **RASIN** low = S0 + S1 + "B" PAL combinational output delay maximum = 62.5 + 15 = 77.5 ns maximum #2) **RASIN** to **RAS** low = 20 ns maximum

#3) RASIN to CAS low = 80 ns (DP8419-80 RASIN -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns

#4) 74F244 transceiver delay = 7 ns maximum

#5) CPU data setup time = 5 ns minimum

"tRAC" = (S0 + S1) + (S2 + S3) + (SW + SW) + S4 (minimum) - #1 - #2 - #4 - #5

= 62.5 + 62.5 + 62.5 + 25 - 77.5 - 20 - 7 - 5

= 103 ns

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= 46 ng Therefore the DRAM chosen should have a "tRAC" less than or equal to 103 ns and a "tCAC" less than or equal to 46 ns V) iAPX 86/88/186/188 Family "tRAC" and "tCAC" Calculations iAPX 86/88 8 MHz No Wait State Calculations #1) RASIN low = Maximum clock high + 15 ns ("B" PAL combinational output delay) = 82 + 15 = 97 ns maximum #2) **BASIN** to **BAS** low = 20 ns maximum #3) **RASIN** to  $\overline{CAS}$  low = 97 ns (DP8419-80  $\overline{RASIN}$  -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 94 ns maximum (using 25 ns minimum row address hold time) #4) 74F245 transceiver delay = 7 ns maximum #5) CPU data setup time to "T4" = 20 ns minimum "tRAC" = T1 + T2 + T3 - #1 - #2 - #4 - #5= 125 + 125 + 125 - 97 - 20 - 7 - 20= 231 ns "tCAC" = T1 + T2 + T3 - #1 - #3 - #4 - #5 = 125 + 125 + 125 - 97 - 94 - 7 - 20= 157 ns Therefore the DRAM chosen should have a "tRAC" less than or equal to 231 ns and a "tCAC" less than or equal to 157 ns. Standard 200 ns DRAMs meet this criteria. iPX 186/188 8 MHz No Wait State Calculations #1) **RASIN** low = Maximum clock high + 15 ns ("B" PAL combinational output delay) = 70 + 15 = 85 ns maximum #2) **RASIN** to **RAS** low = 20 ns maximum #3)  $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  low = 97 ns (DP8419-80  $\overline{\text{RASIN}}$  -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 94 ns maximum (using 25 ns minimum row address hold time) #4) 74F245 transceiver delay = 7 ns maximum #5) CPU data setup time to "T4" = 20 ns minimum "tRAC" = T1 + T2 + T3 - #1 - #2 - #4 - #5= 125 + 125 + 125 - 85 - 20 - 7 - 20= 243 ns"tCAC" = T1 + T2 + T3 - #1 - #3 - #4 - #5 = 125 + 125 + 125 - 85 - 94 - 7 - 20= 169 ns Therefore the DRAM chosen should have a "tRAC" less than or equal to 243 ns and a "tCAC" less than or equal to 169 ns. Standard 200 ns DRAMs meet this criteria. iAPX 86/88 10 MHz No Wait State Calculations #1) **RASIN** low = Maximum clock high + 15 ns ("B" PAL combinational output delay) = 61 + 15 = 76 ns maximum #2)  $\overline{\text{RASIN}}$  to  $\overline{\text{RAS}}$  low = 20 ns maximum

"tCAC" = (S0 + S1) + (S2 + S3) + (SW + SW) + S4

(minimum) - #1 - #3 - #4 - #5

= 62.5 + 62.5 + 62.5 + 25 - 77.5 - 77 - 7 - 5

#3)  $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  low = 80 ns (DP8419-80  $\overline{\text{RASIN}}$  -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns maximum (using 15 ns minimum row address hold time) #4) 74F245 transceiver delay = 7 ns maximum #5) CPU data setup time to "T4" = 5 ns minimum "tRAC" = T1 + T2 + T3 - #1 - #2 - #4 - #5= 100 + 100 + 100 - 76 - 20 - 7 - 5= 192 ns "tCAC" = T1 + T2 + T3 - #1 - #3 - #4 - #5 = 100 + 100 + 100 - 76 - 77 - 7 - 5= 135 ns Therefore the DRAM chosen should have a "tRAC" less than or equal to 192 ns and a "tCAC" less than or equal to 135 ns. Standard 150 ns DRAMs meet this criteria. VI) iAPX 286 "tRAC" and "tCAC" Calculations 6 MHz iAPX 286, 12 MHz Clock, No Wait State Calculations **RASIN** low = T1 + 74AS04 gate delay + "B" #1) PAL clocked output delay = 83.3+ 4.5 + 12 = 100 ns maximum #2) **RASIN** to **RAS** low = 20 ns maximum #3)  $\overline{\text{RASIN}}$  to  $\overline{\text{CAS}}$  low = 80 ns (DP8419-80  $\overline{\text{RASIN}}$  -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns maximum (using 15 ns minimum row address hold time) #4) 74F244 transceiver delay = 7 ns maximum #5) CPU data setup time to "T4" = 20 ns minimum "tRAC" = T1 + T2 + T3 + T4 - #1 - #2 - #4 - #5 = 83.3 + 83.3 + 83.3 + 83.3 - 100 - 20 - 7 - $20 = 186 \, \text{ns}$ "tCAC" = T1 + T2 + T3 + T4 - #1 - #3 - #4 - #5= 83.3 + 83.3 + 83.3 + 83.3 - 100 - 77 - 7 - 720 = 129 ns Therefore the DRAM chosen should have a "tRAC" less than or equal to 186 ns and a "tCAC" less than or equal to 129 ns. Standard 150 ns DRAMs meet this criteria. 7 MHz iAPX 286, 14 MHz Clock, No Wait State Calculations #1) **RASIN** low = T1 + 74AS04 gate delay + "B" PAL clocked output delay = 71.4+ 4.5 + 12 = 88 ns maximum #2) RASIN to RAS low = 20 ns maximum #3) RASIN to CAS low = 80 ns (DP8419-80 RASIN -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns maximum (using 15 ns minimum row address hold time) #4) 74F244 transceiver delay = 7 ns maximum #5) CPU data setup time to "T4" = 10 ns minimum "tRAC" = T1 + T2 + T3 + T4 - #1 - #2 - #4 - #5 = 71.4 + 71.4 + 71.4 + 71.4 - 88 - 20 - 7 - 710 = 160 ns

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"tCAC" = T1 + T2 + T3 + T4 - #1 - #3 - #4 - #5= 71.4 + 71.4 + 71.4 + 71.4 - 88 - 77 - 7 - 10 = 103 ns

Therefore the DRAM chosen should have a "tRAC" less than or equal to 160 ns and a "tCAC" less than or equal to 103 ns. Standard 150 ns DRAMs meet this criteria.

# 8 MHz iAPX 286, 16 MHz Clock, No Wait State Calculations

- #1) RASIN low = T1 + 74AS04 gate delay + "B" PAL clocked output delay = 62.5 + 4.5 + 12 = 79 ns maximum
- #2)  $\overline{\text{RASIN}}$  to  $\overline{\text{RAS}}$  low = 20 ns maximum
- #3) RASIN to CAS low = 80 ns (DP8419-80 RASIN -CAS low) - 3 ns (load of 72 DRAMs instead of 88 DRAMs speced in data sheet) = 77 ns maximum (using 15 ns minimum row address hold time)

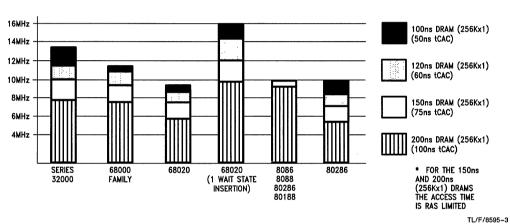
#4) 74F244 transceiver delay = 7 ns maximum

#5) CPU data setup time to "T4" = 10 ns minimum

"tRAC" = T1 + T2 + T3 + T4 - #1 - #2 - #4 - #5= 62.5 + 62.5 + 62.5 + 62.5 - 79 - 20 - 7 -10 = 134 ns

"tCAC" = T1 + T2 + T3 + T4 - #1 - #3 - #4 - #5= 62.5 + 62.5 + 62.5 + 62.5 - 79 - 77 - 7 - 10 = 77 ns

Therefore the DRAM chosen should have a "tRAC" less than or equal to 134 ns and a "tCAC" less than or equal to 77 ns. Standard 120 ns DRAMs meet this criteria.



#### **FIGURE 3**

Note 1: The data presented in this figure is based on typical examples. Faster "no wait state" CPU performance is possible with several of the microprocessors shown above via the use of the DP8419-70 instead of the DP8419-80; the elimination of Data Bus Transceivers; a more tailored PAL (Refresh Access Arbitrator) approach; faster support logic; lower than the 15 $\Omega$  damping resistor specified in the DP8419-80 data sheet; or, less than the specified capacitive load driven directly by the DP8419 (88 DRAMs).

## Dual Port Interface for the DP8417/18/19/28/29 DRAM Controller

## INTRODUCTION

This application note describes a general purpose dual port interface to the DP8417/18/19/28/29 DRAM controller. A PAL® (Programmable Array Logic) device is used to implement this interface. The PAL contains the logic necessary to arbitrate between the three ports (Refresh, Port A, and Port B), provide WAIT states to Port A or B when necessary, and an output to multiplex the Port A or B addresses to the DRAM controller.

### FEATURES

- Provides a versatile dual port interface to the DP8417/ 18/19/28/29 DRAM controller
- Provides arbitration circuitry between DRAM refresh cycles, Port A accesses, and Port B accesses
- Allows for Port A and Port B to be synchronous or asynchronous to the input system clock
- Guarantees a minimum of one and one half system clock periods of RAS precharge time between grants to any two ports
- Provides WAIT state logic to both PORT A and Port B to handle contention problems between ports
- Differentiates between READ and WRITE accesses for Port A allowing Port A WRITE accesses to begin later than READ accesses

#### DESCRIPTION

This hardware arbitrates access to the dynamic RAM controlled by the DP8419 (or any of the related family members: DP8417/18/19/28/29) to either:

1) A Refresh cycle, "GRNTRF"

2) Port A, "GRNTA"

## 3) Port B, "GRNTB"

Refresh always has the highest priority and will always occur immediately upon a refresh request (RFRQ) given that an access by Port A or B is not currently in progress. Port A has a higher priority than Port B though the scheme used attempts to give both ports a more equal priority. The arbiter does this by leaving Port A or Port B granted, after an access by that particular port, as long as no other ports are currently trying to access the DRAM. This scheme is used because data tends to be transferred in bursts from a particular port.

Once a port is granted, subsequent requests by that port immediately access the DRAM, until another port gains access to the DRAM (see *Figure 11* of the timing waveforms for Port A).

The term "WINA" (write enable for Port A) is used to cause "RASIN" to be generated later for a WRITE access than a READ access. This may be necessary to guarantee that valid data is written to the DRAM during WRITE accesses. If Port B is asynchronous this input is not needed because Port B requests are delayed through the external synchronization circuitry. If Port B is synchronous both ports should mux to the "WIN" input, and use this input in generating the "RASIN" output of the PAL. National Semiconductor Application Note 436 Webster (Rusty) B. Meier



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This arbiter guarantees one and one half system clock periods of RAS precharge between accesses of different ports. It is up to the user to guarantee the precharge time between consecutive accesses from the same port. This arbiter assumes a minimum of one period high time between access requests from a particular port.

Hidden Refresh is not supported in any of the following dual port schemes for several reasons:

- If "CS", of the DP8419, is not permanently tied low the user must guarantee a "CS-RASIN" minimum time of 34 ns for the DP8419. This could slow down the access time of several of the dual port schemes presented.
- 2) In order to do hidden refresh a port must be granted during a non-CS access cycle. When the port is granted during a non-CS access cycle the other port may be requesting the dual ported memory also and have to wait for it. A possible problem is that the non-CS access may not even be causing a hidden refresh at that time so in essence the other port is being slowed down for no reason (i.e. a hidden or forced refresh may have already been done during that period of the refresh clock).

If either Port A or B tries to access the DRAM during a refresh WAIT states will automatically be inserted into that port's access cycle. Also if one of the ports tries to access the DRAM while the other port is, WAIT states will automatically be inserted into the appropriate port's access cycle. The user may want to change the "WAIT" state equations depending upon the processor or bus being interfaced to.

The DUAL PORT ARBITER gives access to the refresh cycle via the M2 (RFSH) pin of the DP8419. The GRNTB output of the DUAL PORT CONTROLLER acts as a multiplexor signal to enable either PORT A or PORT B. Once enabled the Port selected will enable its addresses, write enable, LOCK control signal, and data to the DP8419 and its controlled memory. The user must be careful to assure that a particular port will not be locked ("LOCK" low while "GRNTA or B" is low) for more than 15.6  $\mu$ s (RFCK period) or the system may miss a refresh.

The Dual Port scheme presented assumes that all "PORT REQUEST" inputs are synchronous to the system clock input to the PAL (i.e. "PORT REQUESTs" occur following a rising edge of the system clock). If a specific "PORT RE-QUEST" is asynchronous to the system clock it has to be synchronized to the system clock by running it through two flip-flops (see "AREQB" and "ARFRQ" in the system block diagram). The two "RFRQ" synchronizing flip-flops are needed for the PAL refresh logic to work correctly.

The Dual Port scheme presented does not assume the use of any specific processor. Therefore, the user may require some external logic to interface the Dual Port PAL to a specific microprocessor or bus.

Figures 1–5 show several suggestions for circuits used to generate "REQA" for different CPU's. The PAL equations were designed assuming a National Semiconductor Series 32000® CPU on Port A. In the "RASIN" equations for Port A WRITE cycles were started one half period later than READ

cycles and both READ and WRITE accesses were ended one half period after " $\overline{\text{REQA}}$ " went high (this is to make up for WRITE accesses starting one half period after " $\overline{\text{REQA}}$ "). The user may wish to modify these equations (and possibly the "WAITA" equations) depending upon the specific CPU being used.

EXAMPLE: DETERMINING THE REQUIRED MEMORY SPEED (" $t_{RAC}$ " AND " $t_{CAC}$ ") FOR A SERIES 32000 TO RUN AT 10 MHz WITHOUT WAIT STATES

Assume the Series 32000 is synchronously interfaced to Port A.

 #1) RASIN low = T1 + 6 ns (PHI1 to CTTL Rising edge maximum) + 12 ns ("B" PAL clocked output) + 15 ns ("B" PAL combinational output) = 100 + 6 + 12 + 15 = 133 ns maximum

#2)  $\overline{\text{RASIN}}$  to  $\overline{\text{RAS}}$  low = 20 ns maximum

- #3) RASIN to CAS low = 70 ns (DP8419-70) 3 ns (72 DRAMs instead of 88 DRAMs spec'd in data sheet) = 67 ns maximum
- #4) 74F245 transceiver delay = 7 ns maximum
- #5) CPU data setup time to "T4" clock cycle = 15 ns maximum
- "t<sub>BAC</sub>"=T1+T2+T3-#1-#2-#4-#5

$$=100+100+100-133$$
 ns $-20-7-15=125$  ns

"t<sub>CAC</sub>"=T1+T2+T3-#1-#3-#4-#5

=100+100+100-133 ns-67-7-15=78 ns

Therefore the DRAM chosen should have a "t<sub>RAC</sub>" less than or equal to 125 ns and a "t<sub>CAC</sub>" less than or equal to 78 ns. Standard 120 ns DRAMs meet this criteria.

The following is an example of how to interpret the PAL equations correctly. These equations are presented in the format specified by the National Semiconductor PLAN format. CAUTION, this format differs from the much used PALASM format.

EXAMPLE: GRNTRF := RFRQ\*GRNTA\*GRNTB

This reads, the active low flip-flop output "GRNTRF" is low following the rising edge of the input clock given that, the active low input "RFRQ" is low AND the active low output "GRNTA" is high AND the active low output "GRNTB" is high a setup time before the input clock transitions high. (Notice that RFRQ is interpreted as being low.)

#### POSSIBLE MODIFICATIONS TO THIS APPLICATION

In this application "REQB" is synchronized to the falling edge of the system clock input of the PAL. Generating "REQB" from the falling clock edge allows minimum delay from the asynchronous request to the synchronized request producing "GRNTB" and or "RASIN". Producing "REQB" in this way also delays "RASIN" during a port B access because of the effect of the "GTOA" term. In order to calculate the  $t_{RAC}$  and  $t_{CAC}$  of the DRAM (see Series 32000 example above) the delay to "RASIN" low would be: "AREQB" low (asynchronous request B) + SYNCHRONI-ZATION delay (2 flip-flops) + 3 input NAND gate delay of "GTOA" + PAL delay for "RASIN".

If "REQB" is synchronized to the rising edge of the system clock there is a potential danger of getting glitches on the "RASIN" output of the PAL as a result of the "GTOA.B" terms. The glitches are possible under the condition of both "REQA" and "REQB" going low during a single clock period. For example, if Port B is currently granted ("GRNTB" low) and "REQA" goes low more than one inverter gate delay before "REQB" goes low the "GTOA" term will initially be high, then go low, then back high. This could cause a small glitch at the beginning of "RASIN". This glitch can be avoided by guaranteeing that either the requests are separated by at least a three input NAND gate delay (as is the case in this application note) or that when two requests happen within one clock period they happen within one inverter gate delay of each other. The circuits shown below, in Figure 1, could be used to guarantee that when two requests happen within one clock they occur within one gate delay of each other.

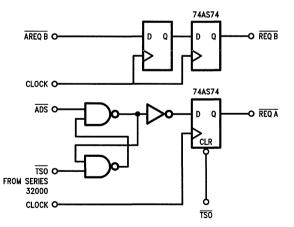
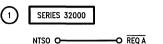


FIGURE 1. Alternative Request Generating Circuits

TL/F/8678-1

#### IDEAS ON GENERATING "REQA" FOR SEVERAL DIFFERENT MICROPROCESSORS.

•REQA, REQB, RFRQ should have a minimum setup time of approximately 20 ns before the rising edge of the system clock.



O NEQ A

#### FIGURE 2. Series 32000 "REQA"

Minimum of 2 periods RAS precharge between successive accesses.

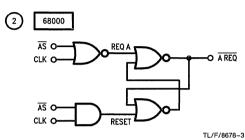
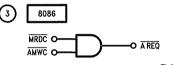


FIGURE 3. 68000 "REQA"

Minimum of 11/2 periods of RAS precharge.



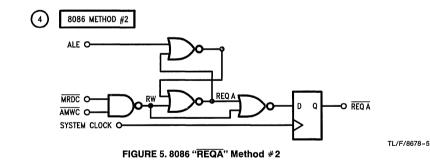
TL/F/8678-4 FIGURE 4. 8086 "REQA" Method # 1

TI /F/8678-2

Minimum of 2 periods of RAS precharge.

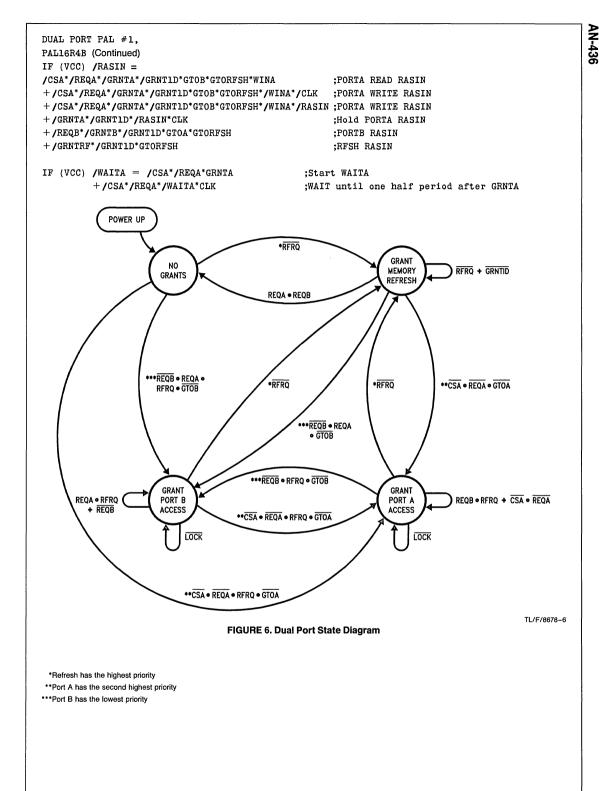
#### **DUAL PORT PAL #1 INPUTS**

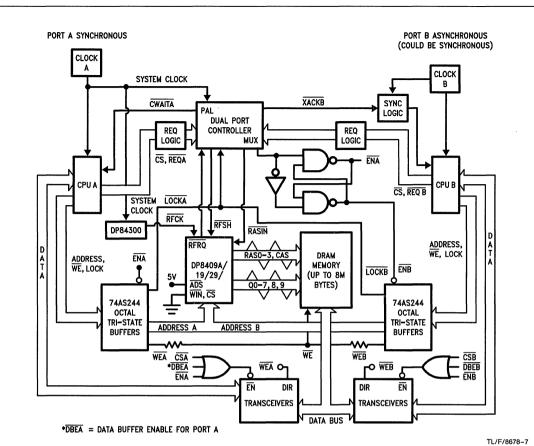
- 1) "CLOCK" System clock.
- 2) "REQA" A synchronous access request from Port A.
- "WINA" WRITE ENABLE from Port A. This input is used to delay "RASIN" during WRITE accesses.
- "REQB" A synchronous chip selected access request form Port B. "AREQB" is run through two flip-flops to get "REQB". Chip Select for Port B is assumed to be included within this input.
- 5) "RFRQ" A synchronous refresh request.
- 6) "LOCK" The "LOCK" input is an active low signal that is driven by either Port A or Port B. This input, when low, causes the arbiter to keep the currently granted Port granted until the "LOCK" input goes high. This input is useful in implementing atomic operations such as semaphores that are useful in multiuser/multitasking operating systems.
- 7) "GTOA" This input is generated externally using the three signals REQA, REQB, and LOCK with some discrete logic. This input indicates that the arbiter will switch to Port A, given that Port B is currently granted. This input is needed to guarantee that when the arbiter switches control of the DRAM from Port B to Port A that GRNTB goes invalid before REQB is able to start another access (see the RASIN output term "PORTB RASIN" in PAL equations).



(For faster speed, minimum of 1 period of RAS precharge.)

| <ol> <li>"GTOB" This input is generated externally using the three signals REQA, REQB, and LOCK with some discrete logic. This input indicates that the arbiter will switch to Port B given that Port A is currently granted. This input is needed to guarantee that when the arbiter switches control of the DRAM from Port A to Port B that GRNTA goes invalid before REQA is able to start another access (see the RASIN output term "PORTA RASIN" in PAL equations).</li> <li>"CLK" This is the system clock input that may be used in the PAL equations (i.e. "WAIT").</li> <li>"CSA" This input is the chip select input for Port A. It is used, along with "REQA", to request and cause an access to the DRAM.</li> <li>DUAL PORT PAL # 1, OUTPUTS</li> <li>NOTE: All outputs are active low.</li> <li>"GRNTA" This output is the grant output for Port A.</li> <li>"GRNTB" This output tis the grant output for Port A.</li> <li>"GRNTB" This output functions as the grant output for both Port A (high) and Port B (low).</li> </ol> | <ol> <li>"GRNTRF" Goes to DP8419 M2 (RFSH) input. This causes an automatic forced refresh cycle.</li> <li>"GRNT1D" Goes low one period after "GRNTA", "GRNTB", or "GRNTRF" go low. This output is used to guarantee that one period is allowed after arbitration before a "RASIN" is generated during a port access. This allows the particular port's address, write enable signal, and lock input to become valid before an access is started. This output also allows the PAL to determine when a particular port has been granted for several system clock periods. This information allows the arbiter to immediately generate "RASIN" for any subsequent memory accesses since the address is already muxed to the DRAM controller (see <i>Figure 11</i> for the timing waveforms for Port A).</li> <li>"WAITA" This output functions as a WAIT input for Port A.</li> <li>"GTORFSH" This input is generated internally and indicates that the arbiter will give access control over to the refresh Port at the next rising clock edge.</li> <li>"XACKB" This output is generated external to the PAL and functions as a transfer acknowledge for Port B.</li> </ol> |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DUAL PORT PAL #1                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| PAL16R4B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| CLOCK /REQA /WINA /REQB /RFRQ /LOCK /GTO<br>/OE /CSA /WAITA /GRNTID /GRNTRF /GRNTB /                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | DA /GTOB CLK GND<br>/GRNTA /RASIN /GTORFSH VCC                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| /GRNTA := /CSA*/REQA*GRNTRF*RFRQ*GRNTB<br>+/LOCK*/GRNTA<br>+/CSA*/REQA*RFRQ*/GRNTRF*GRNTLD<br>+/CSA*/GTOA*/*GRNTB*RFRQ*RASIN<br>+/CSA*/REQA*/GRNTA<br>+/GRNTA*REQB*RFRQ                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | ;Start GRNTA<br>;Continue GRNTA<br>;RFSH_TO_PORTA<br>;PORTB_TO_PORTA<br>;Hold GRNTA<br>;Hold GRNTA                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| <pre>/GRNTB := REQA*GRNTA*RFRQ*GRNTRF*/REQB<br/>+/LOCK*/GRNTB<br/>+/GTOB*/GRNTA*RFRQ*RASIN<br/>+ REQA*RFRQ*/GRNTRF*/REQB*GRNTLD<br/>+/REQB*/GRNTB<br/>+/GRNTB*REQA*RFRQ<br/>+/GRNTB*CSA*RFRQ</pre>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | ;Start GRNTB<br>;Continue GRNTB<br>;PORTA_TO_PORTB<br>;RFSH_TO_PORTB<br>;Hold GRNTB<br>;Hold GRNTB<br>;Hold GRNTB                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| <pre>/GRNTRF := GRNTA*GRNTB*/RFRQ<br/>+/GRNTRF*/RFRQ<br/>+ REQA*/GRNTA*LOCK*/RFRQ<br/>+ REQB*/GRNTB*LOCK*/RFRQ<br/>+/GRNTRF*/GRNTLD</pre>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | ;Start GRNTRF<br>;Continue GRNTRF<br>;PORTA_TO_RFSH<br>;PORTB_TO_RFSH<br>;Hold GRNTRF                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| /GRNT1D := /GRNTA*GTOB*GTORFSH<br>+/GRNTB*GTOA*GTORFSH<br>+/GRNTRF*/RFRQ                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | ;GRNT1D for PORTA<br>;GRNT1D for PORTB<br>;GRNT1D for RFSH                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| IF (VCC) /GTORFSH =                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| REQA*/GRNTA*LOCK*/RFRQ                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | ;PORTA_TO_RFSH                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| + REQB*/GRNTB*LOCK*/RFRQ                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | ;PORTB_TO_RFSH                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| ······································                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | ,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |

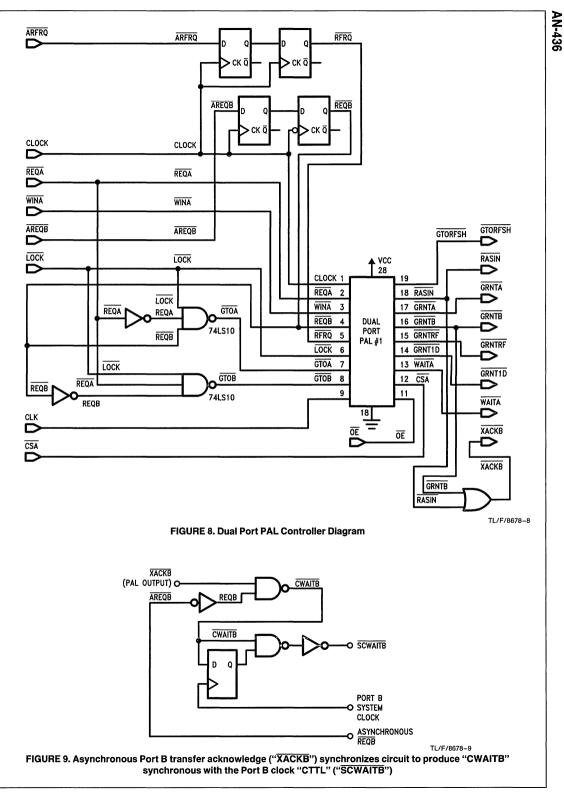




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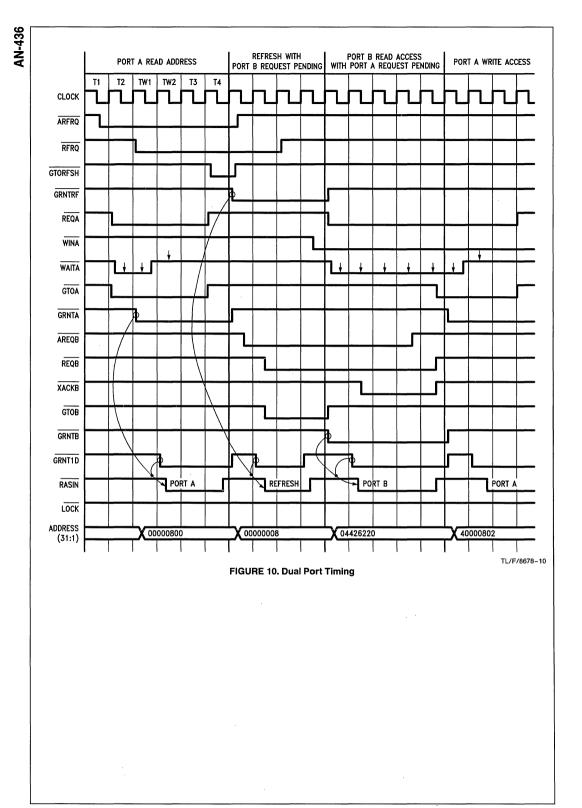


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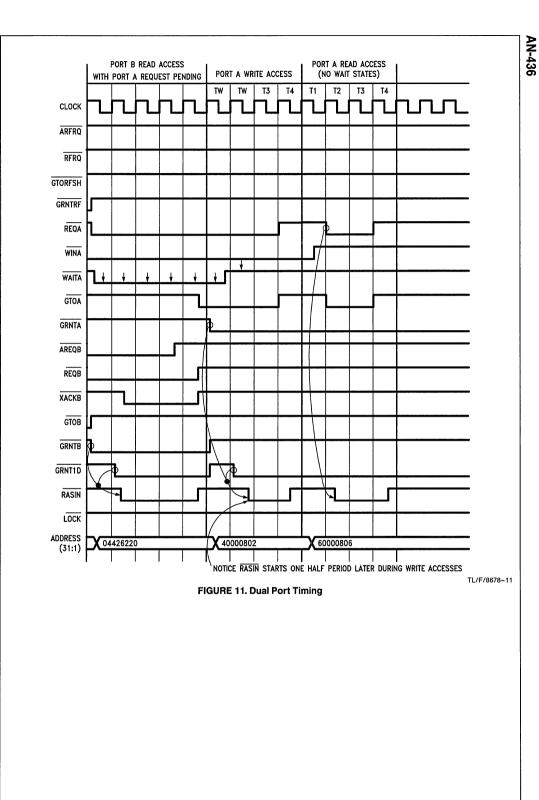


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Section 4 Microprocessor Applications for the DP8420A/21A/22A



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## Explanation of National Semiconductor "PLAN™" Software for Programming PAL®s

INTRODUCTION

The National Semiconductor PLAN software provides interactive design and development tools for system designers who use programmable logic devices (PALs).

The PLAN software package permits a designer to create, with the use of an architecture specific language, an easily read and understood text file to describe a circuit design, select the appropriate device to accommodate the described logic, assign a pin-list to the device, document the design, generate test vectors for the selected devices, and format data to facilitate device programming and functional testing.

PLAN allows the user to assign the device type (type of PAL), generate a pin list to accommodate the equations, and enter the boolean equations that define the PALs operation. The boolean equations are written in the sum-of-products form with architecture defining commands as required.

The sum-of-products formatted boolean equations begin with a symbol representing a device output followed by either the equality ("=") or clock (":=") operator. The sign of the output symbol defines the state of the device output when the equation is satisfied. If the output symbol is preceded by a complement sign ("/") the equation output will be low when the input states defining one of the product terms (of that particular output) are true.

The sum-of-products boolean equations define an output to be true, given that one of the product terms in that output's equations is true. The symbols that make up the sum-ofproducts refer to the state of the input (or output). If a complement sign precedes the input (or output) symbol, in the equation, it means that the input (or output) symbol, in the terue (logic one). Notice that it does not matter whether the input (or output) *pin* has a complement sign preceding it or not, anytime a complement sign precedes an input (or output) *symbol in an equation* that *symbol* must be low to be true (logic one).

Consider the following example (use the PAL pinout and equations listed below to identify the input and output pin names);

EXAMPLE EQUATIONS:

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This example reads: the output "/DC" will transition low given that one of the following conditions are valid;

- 1. the input "/AS" is low AND the input "/CS" is low AND the output "/DB" is low and the input "CLK" is low, OR
- 2. the input "/AS" is low AND the input "/CS" is low AND the output "/DC" is low and the input "CLK" is high

PLAN equations can be converted to PALASM<sup>TM</sup> format very easily. First, the *outputs* of the boolean equations should be complemented. Second, any *symbols* in the boolean equations that are complemented (have "/" preceding the symbol) in the *pin* list should be complemented in the boolean equations. As an example the above mentioned sample equation has been converted to PALASM below;

IF (VCC) DC = AS\*CS\*DB\*/CLK + AS\*CS\*DC\*CLK

Notice that "CLK" does not have a complement sign preceding it in the *pin* list and therefore has the same representation in both the PLAN and the PALASM equations.

## EXAMPLE NATIONAL SEMICONDUCTOR PLAN FORMAT PAL EQUATIONS

PAL16R4D

BCLK /CS /AS NC1 /DTACK /EXST /ADDW CLK NC2 GND

/OE /STERM /DC NC3 /DB /DA NC4 /ENCAS /AREQ VCC

IF (VCC) /AREQ = /AS\*/CS\*CLK +/AREQ\*/CS\*/CLK

IF (VCC) /ENCAS = /AREQ\*/CS\*DC +/AREQ\*/CS\*/CLK

IF (VCC) /STERM = /AS\*/CS\*/DA\*DB\*/CLK\*/ADDW +/AS\*/CS\*/DTACK\*DB\*CLK\*ADDW +/EXST\*/CLK +/STERM\*CLK

/DA := /AREQ\*/CS\*/DTACK\*DB\*/ADDW

/DB := /AREQ\*/CS\*/DTACK\*/DA\*DB\*/ADDW +/AREQ\*/CS\*/DTACK\*DB\*/ADDW

## Interfacing the DP8420A/21A/22A to the NS32008/016/C016/ 032/132

## INTRODUCTION

This application note explains interfacing the DP8420A/21A/22A to the National Semiconductor 32C016. Two different designs are shown and explained. It is assumed the reader is familiar with the NS32C016 access cycles and the DP8420A/21A/22A modes of operation. This application note is written for the NS32C016, but is also valid for the NS32008/016/032/132.

#### **DESIGN DESCRIPTION**

This design is a simple circuit to interface the DP8420A/21A/22A to the NS32C016 and up to 32 Mbytes of DRAM. The DP8420A/21A/22A is operated in mode 0. An access cycle begins when the 32C016 asserts the ADS signal and places a valid address on the bus. The ADS signal places a group of 74AS373 fall-through latches in fallthrough mode and ADS negated latches the address to guarantee the address is valid throughout the entire access. The ADS signal is inverted to produce the signal ALE to the DP8420A/21A/22A. On the next rising clock edge, after the ALE signal is asserted, the DP8420A/21A/22A will assert RAS. After guaranteeing the row address hold time, tRAH, the DP8420A/21A/22A will place the column address on the DRAM address bus, guarantee the column address setup time and assert CAS. The transceivers are enabled by CS and AS. After tCAC, the DRAM will place the data on the bus. The DP8420A/21A/22A will also take care of refresh access arbitration and will hold off the access by asserting the CWAIT signal to the NS32C201 TCU.

Timing parameters are referenced to the numbers shown in the DP842OA/21A/22A data sheet. Times beginning with a "\$" refer to the DP8420A/21A/22A data sheet. Times beginning with a "#" refer to the NS32C016 data sheet. Times beginning with a "!" refer to the NS32C201 data sheet in the 1986 Series 32000® data book. Equations given allow the user the calculation timing based on his frequency and application. The clock to the DELCLK has been chosen to be a multiple of 2MHz. If you do not have a clock, which is a multiple of 2 MHz, the ADS to CAS time must be recalculated.

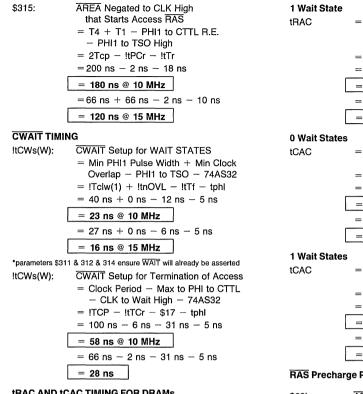
## **DESIGN TIMING PARAMETERS**

| Clock Period | = Tcp10 = 100 ns @ 10 MHz<br>= Tcp15 = 66 ns @ 15 MHz                                                                                                                                                                                                  |
|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| \$300:       | $ \begin{array}{l} \hline CS & asserted to CLK High \\ = T1 - (PHI1 to address + AS373 in \\ to Out + AS138 Decoder + CTTL \\ to PHI1 Max + Inverter) \\ = Tcp - #tALV - tphI - tphI - !tPCr \\ = 100 ns - 50 ns - 6 ns - 9 ns - 2 ns \\ \end{array} $ |
|              | = 33 ns @ 10 MHz                                                                                                                                                                                                                                       |
| -            | = 66 ns - 35 ns - 6 ns - 9 ns - 2 ns                                                                                                                                                                                                                   |
|              | = 14 ns @ 15 MHz                                                                                                                                                                                                                                       |
|              |                                                                                                                                                                                                                                                        |

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| \$301b:          | ALE Setup to CLK High<br>= T1 - Inverter Max - PHI1 to ADS<br>- CTTL to PHI1<br>= Tcp - tplh - #tADSa - !tPCr<br>= 100 ns - 5 ns - 35 ns - 2 ns                                             |
|------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                  | = 55 ns @ 10 MHz                                                                                                                                                                            |
|                  | = 66 ns - 5 ns - 26 ns - 2 ns                                                                                                                                                               |
|                  | = 33 ns @ 15 MHz                                                                                                                                                                            |
| \$302:           | ALE Pulse Width<br>= T1 - Inverter Max - PHI1 to ADS<br>- CTTL to PHI1<br>= #tADSw                                                                                                          |
|                  | = 30 ns @ 10 MHz                                                                                                                                                                            |
|                  |                                                                                                                                                                                             |
|                  | = 25 ns @ 15 MHz                                                                                                                                                                            |
| \$303 & \$304:   | <ul> <li>Address Setup to CLK</li> <li>T1 - PHI1 to Address + AS373 in to out<br/>+ CTTL to PHI1 Max)</li> <li>Tcp - #tADSa - tphl - ltPCr</li> <li>100 ns - 50 ns - 6 ns - 2 ns</li> </ul> |
|                  | = 42 ns @ 10 MHz                                                                                                                                                                            |
|                  | = 66  ns - 35  ns - 6  ns - 2  ns                                                                                                                                                           |
|                  | = 23 ns @ 15 MHz                                                                                                                                                                            |
| \$309:           | ALE Negated Held from CLK High<br>= Min CLK to ADS + Min Inverter<br>- CTTL to PHI1 Max<br>= Min CLK to ADS + 1 ns - 2 ns                                                                   |
|                  | = Min CLK to ADS - 1 ns @ 10 MHz                                                                                                                                                            |
|                  | = Min CLK to ADS - 1 ns @ 15 MHz                                                                                                                                                            |
| * no time is spe | cified for CLK to ADS min.*                                                                                                                                                                 |
| \$310:           | WIN Setup to CLK High to Guarantee<br>CAS is Delayed                                                                                                                                        |
|                  | = T1 + T2 $-$ PHI1 to CTTL R.E.                                                                                                                                                             |
|                  | <ul> <li>DDIN Signal Valid - 74AS04</li> <li>2Tcp - !tPCr - #tDDINv - tphi</li> </ul>                                                                                                       |
|                  | = 200  ns - 2  ns - 45  ns - 5  ns                                                                                                                                                          |
|                  |                                                                                                                                                                                             |
|                  | = 148 @ 10 MHz                                                                                                                                                                              |
|                  | = 66  ns + 66  ns - 2  ns - 38  ns - 5  ns                                                                                                                                                  |
|                  | = 87 ns @ 15 MHz                                                                                                                                                                            |
|                  |                                                                                                                                                                                             |



### tRAC AND tCAC TIMING FOR DRAMs

Timing diagrams are supplied on page 8. Since systems and DRAM times vary, the user is encouraged to change the following equations to match his system requirements. Timing has been supplied for systems with 0 or 1 wait states. If DELCLK is not a multiple of 2 MHz the CLK to CAS delay must be recalculated.

#### 0 Wait States

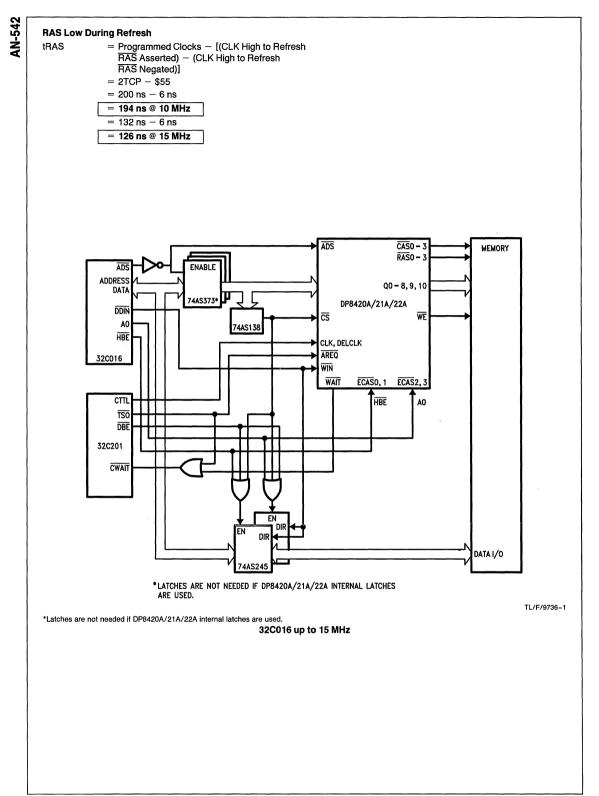
tRAC = T2 + T3 - Max Clock Skew - CLK to RAS - Transceiver Delay - Data Setup = 2TCP - !tPCr - \$307 - tphl - #tDls = 200 ns - 6 ns - 26 ns - 7 ns - 15 ns = 146 ns @ 10 MHz = 2Tcp - !tPCr - \$307 - tphl - #tDls = 132 ns - 2 ns - 26 ns - 7 ns - 10 ns

- = T2 + TW + T3 Max Clock Skew - CLK to RAS - Transceiver Delay Data Setup = 3Tcp - !tPCr - \$307 - tphi - #tDis = 300 ns - 6 ns - 26 ns - 7 ns - 15 ns= 246 ns @ 10 MHz = 198 ns - 2 ns - 26 ns - 7 ns - 10 ns = 153 ns @ 15 MHz
- = T2 + T3 Max Clock Skew CLK to RAS - Transceiver Delay - Data Setup = 2Tcp - !tPCr - \$308a - tphl - #tDls = 200 ns - 6 ns - 79 ns - 7 ns - 15 ns = 93 ns @ 10 MHz = 132 ns - 2 ns - 79 ns - 7 ns - 10 ns = 34 ns @ 15 MHz

| tCAC | $= \underline{T2} + \underline{T3} - Max Clock Skew - CLK to$ $\overline{CAS} - Transceiver Delay - Data Setup$ $= 3Tcp - \underline{ItPCr} - \underline{\$308a} - \underline{tphl} - \underline{\#tDls}$ $= 300 \text{ ns} - 6 \text{ ns} - 79 \text{ ns} - 7 \text{ ns} - 15 \text{ ns}$ |
|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|      | = 193 ns @ 10 MHz                                                                                                                                                                                                                                                                          |
|      | = 198 ns - 2 ns - 79 ns - 7 ns - 10 ns                                                                                                                                                                                                                                                     |
|      | = 100 ns @ 15 MHz                                                                                                                                                                                                                                                                          |

### **RAS** Precharge Parameters

| \$29b: | AREQ Negated Setup to CLK<br>= Clock Period - Clock Skew PHI1<br>to CTTL - PHI1 to TSO<br>= TCP - ItPCr - ItTr<br>= 100 ns - 2 ns - 18 ns                                                                                   |
|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|        | = 80 ns @ 10 MHz                                                                                                                                                                                                            |
|        | = 66 ns - 2 ns - 10 ns                                                                                                                                                                                                      |
|        | = 54 ns @ 15 MHz                                                                                                                                                                                                            |
| tRP    | <ul> <li>Programmed Clocks - Clock Skew PHI1<br/>to CTTL - PHI1 to TSO</li> <li>- [(AREQ to RAS Negated) - (CLK to<br/>RAS Asserted)]</li> <li>2TCP - !tPCr - !tTr - \$50</li> <li>200 ns - 2 ns - 18 ns - 16 ns</li> </ul> |
|        | = 164 ns @ 10 MHz                                                                                                                                                                                                           |



|            | Design Programming Bits                  |                               |
|------------|------------------------------------------|-------------------------------|
| Bits       | Description                              | Value                         |
| R0, R1     | $\overline{RAS}$ Low During Refresh = 2T | R0 = 0                        |
|            | $\overline{RAS}$ Precharge Time = 2T     | R1 = 1                        |
| R2, R3     | WAIT Generation Mode during              | R2 = u                        |
|            | Non-Burst Access                         | R3 = u                        |
| R4, R5     | WAIT During Burst                        | R4 = 0                        |
|            |                                          | R5 = 0                        |
| R6         | ADD Wait States with WAITIN              | R6 = x                        |
| R7         | WAIT Mode Selected                       | R7 = 0                        |
| R8         | Non-Interleaved Mode                     | R8 = 1                        |
| R9         | Staggered or all RAS Refresh             | R9 = u                        |
| C0, C1, C2 | Divisior for DELCLK                      | C0 = *                        |
|            | *Use a Multiple of 2 MHz External Clock  | C1 = *                        |
|            |                                          | C2 = *                        |
| C3         | + 30 REFRESH                             | C3 = *                        |
| C4, C5, C6 | RAS, CAS Configuration Mode              | C4 = **                       |
|            | **Choose an all CAS Mode,                | C5 = **                       |
|            | Tie a CAS to Each Nibble                 | C6 = **                       |
| C7         | Select 0 ns Column Address Setup         | C7 = 1                        |
| C8         | Select 15 ns Row Address Hold            | C8 = 1                        |
| C9         | CAS is Delayed During Writes             | C9 = 1                        |
| В0         | Latches are Fall-Through                 | B0 = 1                        |
| B1         | Access Mode 0                            | B1 = 0                        |
| ECAS0      | Non-Extend CAS Mode                      | $\overline{\text{ECAS}}0 = 0$ |

x = don't careu = user defined

----

| = | usei | de | tin |
|---|------|----|-----|
|   | R2   |    | 0   |
|   | R2   | =  | 1   |
|   | R9   | =  | 0   |
|   | R9   | =  | 1   |
|   |      |    |     |

R3 = 1 R3 = 0

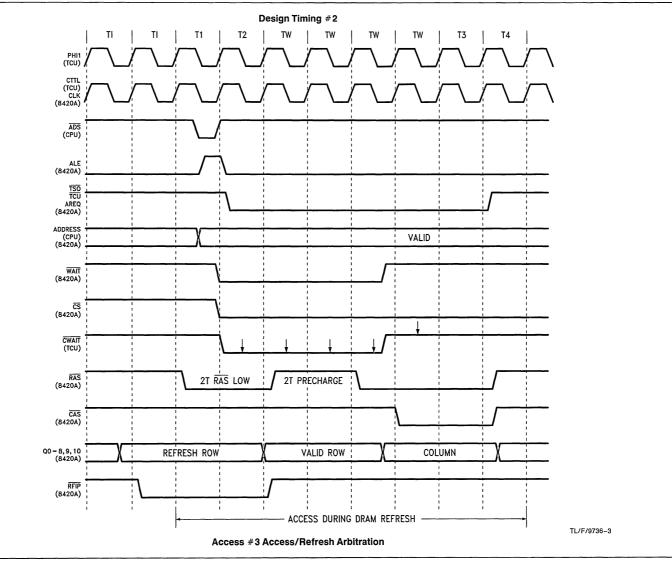
| for 0 WAIT STATES<br>for <u>1 WAIT STATE</u><br>all RAS refresh |
|-----------------------------------------------------------------|
| staggered refresh                                               |

4

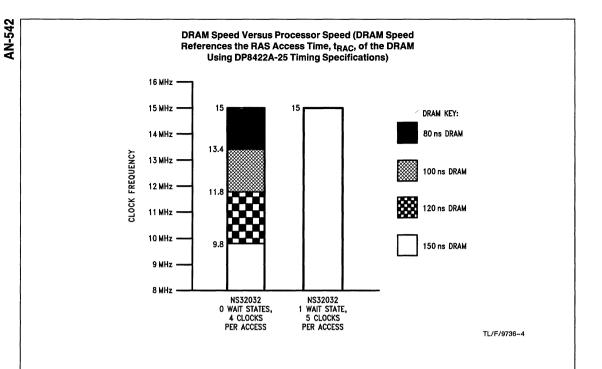
Design Timing #1 T1 T2 T3 T2 ΤW T3 **T4** T4 T1 PHI1 (TCU) CTTL (TCU) CLK (8420A) ADS (CPU) ALE (8420A) TSO TCU AREQ (8420A) ADDRESS (CPU) (8420A) VALID VALID 1 ı . . 1 1 WAIT (8420A) CS (8420A) CWAIT (TCU) RAS (8420A) CAS (8420A) Q0 - 8, 9, 10 (8420A) RÓW COLUMN ROW COLUMN \_\_\_\_ACCESS #1 0 WAIT STATES ACCESS #2 1 WAIT STATE TL/F/9736-2

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4-8



4-9



## Interfacing the DP8420A/21A/22A to the National Semiconductor NS32332

**I INTRODUCTION** 

This application note describes how to interface the National Semiconductor NS32332 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). There are four designs shown in this application note. The differences between these designs are as follows:

- 1. Design #1 can be used up to 14 MHz, has no wait states in normal accesses and no wait states in burst accesses, does not contain an MMU unit, is programmed with  $\overline{\text{DTACK0}}$  out of the DP8422A, and has the  $\overline{1W}$  input of the PAL tied high,
- Design #2 can be used up to 15 MHz, has one wait state in normal accesses and no wait states in burst accesses, does not contain an MMU unit, is programmed with DTACK1 out of the DP8422A, and has the 1W input of the PAL tied high,
- Design #3 can be used up to 14 MHz, has one wait state in normal accesses and no wait states in burst accesses, does contain an MMU unit, is programmed with DTACKO out of the DP8422A, and has the 1W input of the PAL tied high,
- 4. Design #4 can be used up to 15 MHz, has two wait states in normal accesses and no wait states in burst accesses, does contain an MMU unit, is programmed with DTACK1 out of the DP8422A, and has the 1W input of the PAL tied high,

An extra wait state can also be added to any of the four above designs by tying the  $\overline{1W}$  input low. It is assumed that the reader is already familiar with NS32332 and the DP8422A modes of operation.

#### II DESCRIPTION OF FOUR DESIGNS, ALLOWING UP TO 15 MHz OPERATION WITH 0, 1, OR 2 WAIT STATES IN NORMAL ACCESSES, NO WAIT STATES IN BURST ACCESSES AND AN OPTIONAL MMU (MEMORY MANAGEMENT UNIT, NS32382)

These four designs are all similar. Taken together they allow the user to design a 32332 DRAM system with 0, 1, or 2 wait states during an access. This system can be designed with or without the NS32382 MMU. These designs are shown driving two banks of DRAM, each bank being 32 bits in width, giving a maximum memory capacity of 32 Mbytes (using 4 Mbit x 1 DRAMs). By choosing a different RAS and CAS configuration mode (see programming mode bits section of DP8422A data sheet), this application could support 4 banks of DRAM, giving a memory capacity of 64 Mbytes (using 4 Mbit x 1 DRAMs).

Note: When driving 64 Mbytes, the timing calculations will have to be adjusted to the greater capacitive load. National Semiconductor Application Note 543 Webster (Rusty) Meier Jr. and Joe Tate



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The memory banks are interleaved on every four word (32bit word) boundary. This means that the address bit (A4) is tied to the bank select input of the DP8422A (B1). If the majority of accesses made by the NS32332 are sequential, the NS32332 can be doing burst accesses most of the time. Each burst of four words can alternate memory banks, allowing one memory bank to be precharging (RAS precharge) while the other bank is being accessed. This is a higher performance memory system than a non-interleaved memory system (bank select on the higher address bits). Each back to back memory access to the same memory bank will generally require extra wait states to be inserted into the CPU access cycles to guarantee the  $\overline{RAS}$  precharge time.

The logic shown in this application note forms a complete NS32332 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A. arbitration between Port A, Port B, and refreshing the DRAM;
- B. the isertion of wait states to the processor (Port A and Port B) when needed (i.e., if RAS precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access ... etc.);
- C. performing byte writes and reads to the 32-bit words in memory.

By making use of the enable input on the 74AS373 latch, this application can easily be used in a dual access application. The addresses and chip select are TRI-STATE<sup>®</sup> through this latch, the write input (WIN), lock input (LOCK), and ECASO-3 inputs must also be able to be TRI-STATE (a 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B), the DP8422A can be used in a dual access applications. All the timing (see TIMING section of this application note) will remain the same whether single or dual accessing is implemented.

If an MMU (NS32382) is used the signal "PAV" should be input to the PAL " $\overline{ADS}$ " input instead of the NS32332  $\overline{ADS}$ input. If wanted the user could input the MADS signal to the PAL (using the "NC1" input), allowing the access cycle to be started one clock earlier. When the PAL senses the MADS input transitioning low it can insert one less wait state into that particular access.

The PAL output term  $\overline{D1}$  and the input term  $\overline{1W}$  can be deleted from the PAL if the user is not interested in adding an extra wait state to any of the four designs.

### III NS32332 DESIGN, UP TO 15 MHz WITH 0, 1, OR 2 WAIT STATES IN NORMAL ACCESSES AND NO WAIT STATES IN BURST ACCESSES, PROGRAMMING MODE BITS

| Programming<br>Bits           | Description                                                              |
|-------------------------------|--------------------------------------------------------------------------|
| R0 = 0                        | RAS Low Two Clocks, RAS                                                  |
| R1 = 1                        | Precharge of Two Clocks                                                  |
| R2 = X                        | Choose depending on whether design                                       |
| R3 = X                        | 1-4 is chosen. Choose R2,3 = 0,0 if                                      |
|                               | $\overline{\text{DTACK0}}$ is wanted. Choose R2,3 =                      |
|                               | 1,0 if DTACK1 is wanted (DTACK low                                       |
|                               | first rising CLK edge after access RAS                                   |
|                               | is low).                                                                 |
| R4 = 0                        | No WAIT states during burst accesses                                     |
| R5 = 0                        |                                                                          |
| R6 = 0                        | If $\overline{\text{WAITIN}} = 0$ , add one clock to                     |
|                               | DTACK. Since we are not using the WAITIN input it should be tied high on |
|                               | the DP8422A.                                                             |
| R7 = 1                        | Select DTACK                                                             |
| R8 = 1                        | Non-interleaved mode                                                     |
| R9 = X                        |                                                                          |
|                               |                                                                          |
| C0 = X                        | Select based upon the input                                              |
| C1 = X                        | "DELCLK" frequency. Example: if the                                      |
| C2 = X                        | input clock frequency is 14 MHz then                                     |
| C3 = X                        | choose C0,1,2, $=$ 1,1,0 (divide by                                      |
|                               | seven, this will give a frequency of 2 MHz).                             |
| C4 = 0                        | RAS groups selected by "B1". This                                        |
| C5 = 0                        | mode allows two RAS outputs to go                                        |
| C6 = 1                        | low during an access, and allows byte                                    |
|                               | writing 32-bit words.                                                    |
| C7 = 1                        | Column address setup time of 0 ns                                        |
| C8 = 1                        | Row address hold time of 15 ns                                           |
| C9 = 1                        | Delay CAS during write accesses to                                       |
|                               | one clock after RAS transitions low                                      |
| B0 = 1                        | Fall-thru latches                                                        |
| B1 = 0                        | Access mode 0                                                            |
| $\overline{\text{ECAS}}0 = 0$ | CAS not extended beyond RAS                                              |
| 0 = program with low          | -                                                                        |
| 1 = program with high         | -                                                                        |
| X = program with eithe        | er high or low voltage level (don't care condition)                      |
| IV NS32332 DES                | GN #2 (NO MMULINIT) AT 15 MHz                                            |

IV NS32332, DESIGN #2 (NO MMU UNIT) AT 15 MHz WITH ONE WAIT STATE IN NORMAL ACCESSES, DESIGN #4 (HAS MMU UNIT) AT 15 MHz WITH TWO WAIT STATES IN NORMAL ACCESSES. DESIGNS #2 AND #4 HAVE A TOTAL OF THREE CLOCK PERIODS TO ACCESS THE DRAM IN NORMAL ACCESSES AND HAVE ZERO WAIT STATES DURING BURST ACCESSES.

1. Maximum time to latch enable valid:

 $\overline{\text{ADS}}$  makes the 74AS373 fall-thru at 17 ns (max) from PHI1 CLOCK low + 5 ns (74AS04) + 2 ns (PHI1 to CTTL clock skew) = 24 ns

•Note: MADS and PAV are valid 17 ns maximum from PHI1 rising clock edge if NS32382 is used

- 2. Maximum time to address valid from CTTL CLOCK (NS32332 spec) = 20 ns (address valid from PHI1 clock) + 2 ns (PHI1 to CTTL clock skew) = 22 ns
- Maximum time to latched address valid from CTTL CLOCK:

11.5 ns (74AS373 enable time maximum) + 24 ns (#1) = 35.5 ns

 Minimum ALE high setup time to CLOCK high (DP8422A-25 needs 15 ns):

66.6 ns (one clock period) - 17 ns (NS32332 max time to  $\overline{\text{ADS}}$  low from PHI1) - 2 ns (PHI1 to CTTL clock skew) - 15 ns (PAL16R6B combinational output) - 5 ns (74AS04) = 27.6 ns

5. Minimum address setup time to CLOCK high (DP8422A-25 needs 18 ns):

66.6 ns (one clock period) - 35.5 ns (#3) = 31.1 ns

6. Minimum  $\overline{\text{CS}}$  setup time to CLOCK high (DP8422A-25 needs 13 ns):

66.6 ns (one clock period) - 35.5 ns (#3) - 9 ns (Max 74AS138 decoder) = 22.1 ns

- 7. Determining  $t_{\mbox{\scriptsize RAC}}$  (RAS access time required by the DRAM):
- 199.8 ns (three clock periods to do access) 2 ns (NS32C201 PHI1 to CTTL clock skew) 7 ns (data setup time) - 7 ns (74F245) - 26 ns (CLK to RAS low on DP8422A-25) = 157.8 ns. Therefore the  $t_{RAC}$  of the DRAM must be 157.8 ns or less.
- 8. Determining t<sub>CAC</sub> (CAS access time) and column address access time required by the DRAM:

199.8 ns -2 ns -7 ns -7 ns -12 ns (74AS32, 6 ns, plus 6 ns extra, taken from lab data on the 74AS32, requried to drive a 22 $\Omega$  damping resistor and an equivalent load capacitance of 150 pF, approximately 16 DRAM CAS inputs per CASGn output) -72 ns (CLK to CAS low on DP8422A-25) = 99.8 ns. Therefore the t<sub>CAC</sub> of the DRAM must be 99.8 ns or less.

9. Determining the nibble mode access time required by the DRAM:

66.6 ns (T3 clock) - 2 ns (clock skew) - 12 ns (PAL16R6B, CASEN clocked output) - 12 ns (74AS32, see #8 description) - 7 ns (74F245) - 7 ns (data setup) = 26.6 ns

Therefore the nibble mode access time needed by the DRAM must be 26.6 ns or less.

10. Maximum time to DTACK0 low (PAL16R6B needs 15 ns setup to CTTL):

66.6 ns (one clock) - 33 ns (DTACK0 low from CLK high on DP8422A-25) = 33.6 ns

\*\*Note that DTACK1 may be used from some of the designs, it occurs at 28 ns maximum from the CLK input.

11. Minimum RDY setup time to RDY being sampled (12 ns to the PHI1 falling edge is needed by the NS32332):

27.3 ns (minimum PHI1 high pulse width) - 2 ns (NS32C201 PHI1 to CTTL clock skew) - 12 ns (PAL16R6B clocked output maximum) = 13.3 ns

\*Note: Calculations can be performed for different frequencies and the other designs (#1 and #3) by substituting the appropriate values into the above equations. Design numbers 1 and 3 have only two clock periods to perform an access, therefore the t<sub>RAC</sub> and t<sub>CAC</sub> calculations would be affected by having one less clock period during an access.

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### V NS32332 DESIGN, PAL EQUATIONS WRITTEN IN NATIONAL SEMICONDUCTOR PLAN FORMAT PALLEREB

CTTL /CS /ADS /BOUT /DTACK EXRDY /1W RESET NC1 GND /OE /EN\_TRAN NC2 /AREQ /CASEN /D2 /D1 RDY

ADSL VCC

IF (VCC) /ADSL = /ADS

+/ADSL\*AREQ\*/RESET +/ADSL\*/BOUT\*/CS +/ADSL\*/CASEN\*/CS

- IF (VCC) /EN=\_TRAN = /AREQ\*/CS\*/CASEN +/EN\_TRAN\*/BOUT
- RDY := /CS\*/ADSL\*D1\*/1W +/CS\*/ADSL\*DTACK\*D2\*1W
- /Dl := /DTACK\*Dl\*/lW\*/CS\*/RESET
   +\*/EXRDY\*CS\*/lW
- /D2 := /CS\*/D1\*/1W\*/RESET +/CS\*/DTACK\*D2\*1W\*/RESET +CS\*/EXRDY\*1W\*/RESET
- /CASEN := /ADSL\*D2\*/RESET +AREQ\*/RESET
- /AREQ := /ADSL\*/RESET

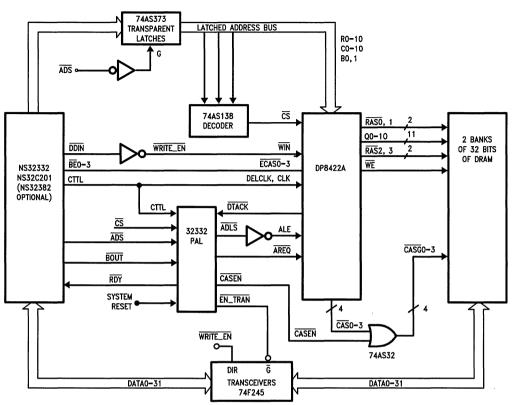
### Key: Reading PAL<sup>®</sup> Equations Written in PLAN™

EXAMPLE EQUATIONS: /CASEN := /ADSL\*D2\*/RESET +AREQ\*/RESET

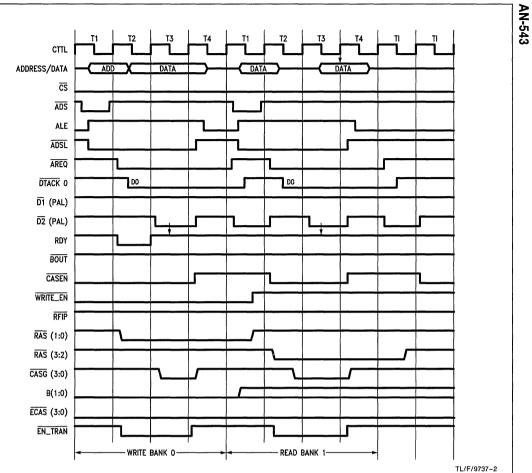
This example reads: the output "/CASEN" will transition low on the next rising "CTTL" clock edge (given that one of the following conditions are valid a setup time before "CTTL" transitions high);

- 1. the output "/ADSL" is low AND the output "/D2" is high AND the input "RESET" is low, OR
- 2. the output "/AREQ" is high AND the input "RESET" is low

### NS32332 Design, up to 15 MHz, May Include MMU; 0, 1, or 2 Wait States per Normal Access, No Wait States in Burst Accesses (74AS373 latches are not needed if address and bank inputs meet setup and hold times of ALE and DP8422A is programmed to latch the addresses)



TL/F/9737-1



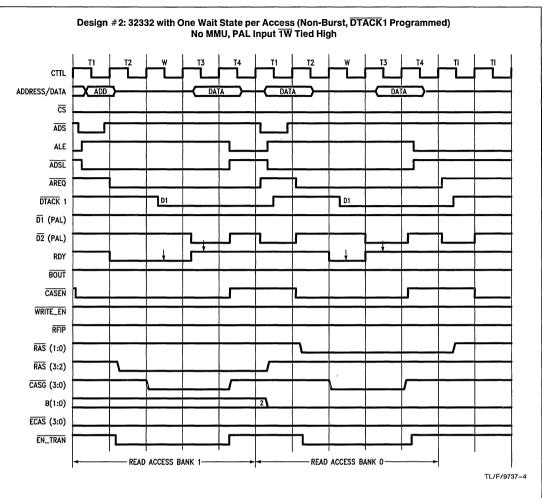
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Design # 1: 32332 with No Wait States (No MMU, PAL Input Tw Tied High)

4

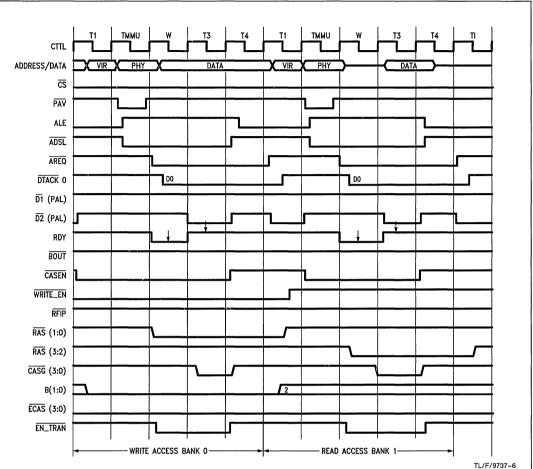
T3 Т3 T4 T1 T2 W1 W2 <u>₩</u>3 <u>₩</u>4 W5 T3 T2 T4 T3 T4 T4 Τ1 Π CTTL ADDRESS/DATA ADD DATA DATA DATA ADD DATA σī ADS ALE ADSL AREQ **D**0 DTACK 0 00 D1 (PAL) D2 (PAL) v RDY BOUT CASEN WRITE\_EN RFIP REFRESH RAS (1:0) PRECHARGE RAS (3:2) PRECHARGE CASG (3:0) X1 2 B(1:0) 2 ECAS (3:0) EN\_TRAN ACCESS DURING DRAM REFRESH-BURST READ ACCESS TL/F/9737-3 Design # 1: 32332 with No Wait States (No MMU, PAL Input 1W Tied High)

4-16



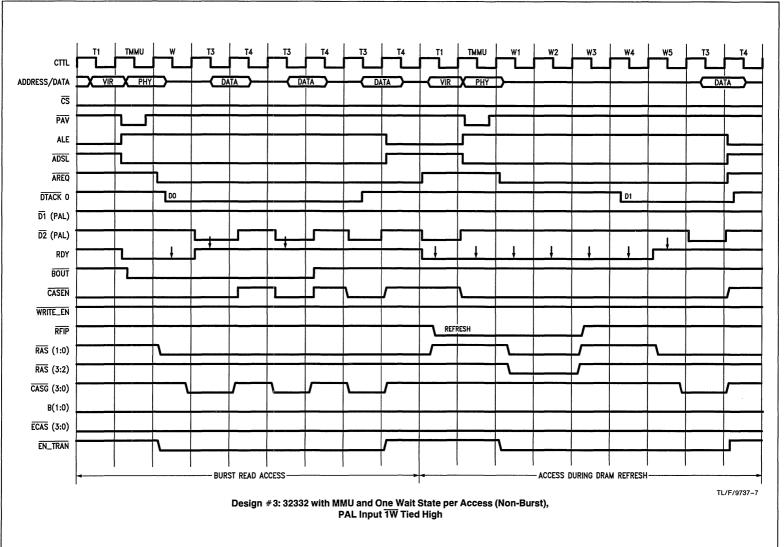
T2 T4 T2 W1 <u>₩</u>2 T3 T4 T3 T1 W3 W4 ₩5 T6 T3 **T4** П CTTL ADDRESS/DATA ADD DATA DATA ADD DATA σs PAV ALE ADSL AREQ DTACK 1 D1 **D**1 D1 (PAL) D2 (PAL) 1 RDY BOUT CASEN WRITE\_EN REFRESH RFIP RAS (1:0) RAS (3:2) CASG (3:0) B(1:0) **ECAS** (3:0) EN\_TRAN BURST READ ACCESS - ACCESS DURING DRAM REFRESH 1 TL/F/9737-5 Design #2: 32332 with One Wait State per Access (Non-Burst, DTACK1 Programmed), No MMU, PAL Input 1W Tied High

4-18

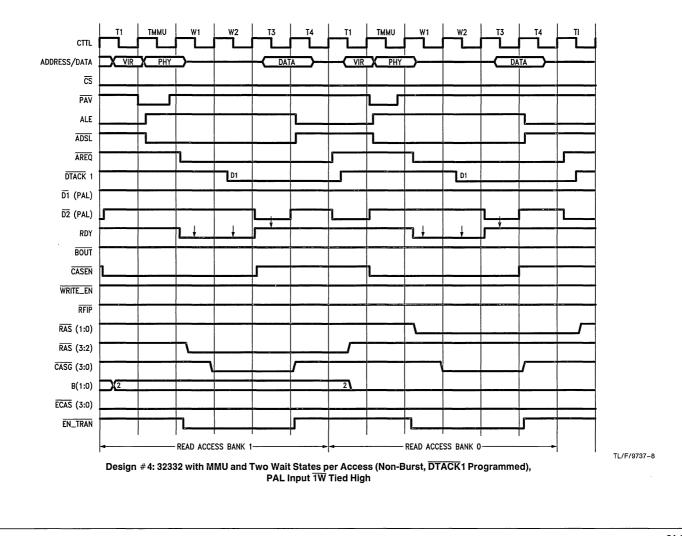


Design #3: 32332 with MMU and One Wait State per Access (Non-Burst), PAL Input  $\overline{1W}$  Tied High

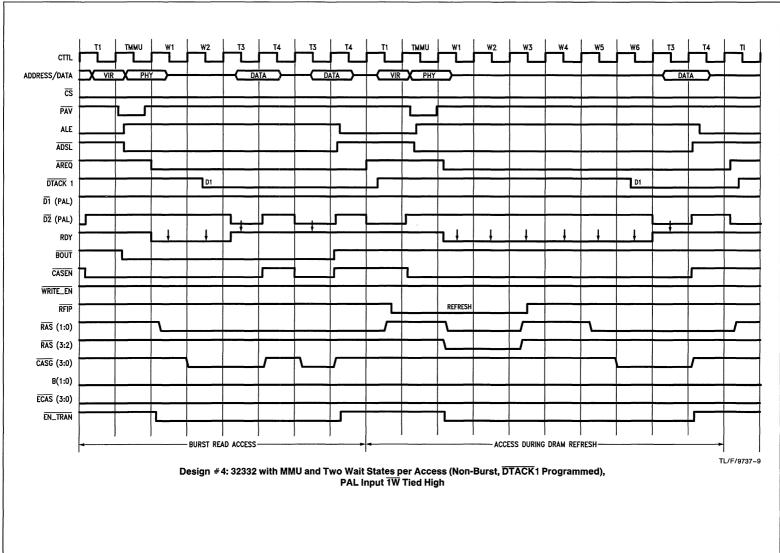
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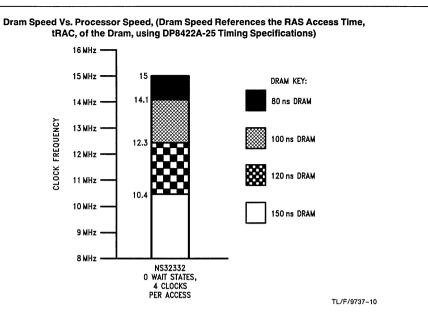


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### Interfacing the DP8420A/21A/22A to the National Semiconductor NS32532

### **1.0 INTRODUCTION**

This application note describes how to interface the National Semiconductor NS32532 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). It is assumed that the reader is already familiar with NS32532 and the DP8422A modes of operation.

#### 2.0 DESCRIPTION OF DESIGN, ALLOWING UP TO 25 MHz OPERATION WITH 2 OR 3 WAIT STATES IN NORMAL ACCESSES AND 1 WAIT STATE DURING BURST ACCESSES

This design drives two banks of DRAM, each bank being 32 bits in width, giving a maximum memory capacity of 32 Mbytes (using 4 Mbit x 1 DRAMs). By choosing a different RAS and CAS configuration mode (see programming mode bits section of DP8422A data sheet) this application could support 4 banks of DRAM, giving a memory capacity of 64 Mbytes (using 4 Mbit x 1 DRAMs, NOTE that when driving 64 Mbytes the timing calculations will have to be adjusted to the greater capacitive load).

The memory banks are interleaved on every four word (32bit word) boundary. This means that the address bit (A4) is tied to the bank select input of the DP8422A (B1). If the majority of accesses made by the NS32532 are sequential, the NS32532 can be doing burst accesses most of the time. Each burst of four words can alternate memory banks, allowing one memory bank to be precharging (RAS precharge) while the other bank is being accessed. This is a higher performance memory system than a non-interleaved memory system (bank select on the higher address bits). Each separate memory access to the same memory bank will generally require extra wait states to be inserted into the CPU access cycles to allow for the RAS precharge time.

This design supports the NS32532 burst access operations. To support these operations it is assumed that nibble mode DRAMs will be used. (See the timing calculations, Section IV).

National Semiconductor Application Note 541 Webster (Rusty) Meier Jr. and Joe Tate



The logic shown in this application note forms a complete NS32532 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A arbitration between Port A, Port B, and refreshing the DRAM;
- B the insertion of wait states to the processor (Port A and Port B) when needed (i.e., if **FAS** precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access ... etc);
- C performing byte writes and reads to the 32-bit words in memory.

The Confirm Bus Cycle (CONF) signal is input to the DP8422A Chip Select ( $\overline{CS}$ ) input. Therefore the  $\overline{CONF}$  signal disables the current access, from the DP8422A, if the NS32532 has cancelled it ( $\overline{CONF}$  high setup to  $\overline{ADS}$  transitioning low). The PAL starts an access via the DP8422A by pulling the  $\overline{ADS}$ ,  $\overline{AREQ}$  inputs low. These inputs are brought low given that  $\overline{CS}$  and Begin Memory Transaction ( $\overline{BMT}$ ) are both low.

By making use of the enable input on the 74AS244 buffer, this application can easily be used in a dual access application. The addresses and chip select are TRI-STATE® through this buffer, the write input (WIN), lock input (LOCK), and ECAS0-3 inputs must also be able to be TRI-STATE (another 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B) the DP8422A can be used in a dual access application. If this design is used in a dual access application at 25 MHz the  $t_{\rm RAC}$  and  $t_{\rm CAC}$  (required RAS and CAS access time required by the DRAM) will have to be recalculated since the time to RAS and CAS is longer for the dual access application (see TIMING section of this application note).

#### 3.0 NS32532 DESIGN, UP TO 25 MHz WITH 2 OR 3 WAIT STATES DURING NORMAL ACCESSES AND 1 WAIT STATE DURING BURST ACCESSES, PROGRAMMING MODE BITS

| Programming<br>Bits           | Description                                                        |
|-------------------------------|--------------------------------------------------------------------|
| R0 = 1                        | RAS low four clocks, RAS                                           |
| R1 = 1                        | precharge of three clocks.                                         |
| R2 = 1                        | DTACK1 is chosen. DTACK low                                        |
| R3 = 0                        | first rising CLK edge after access                                 |
|                               | RAS is low.                                                        |
| R4 = 0                        | No Wait states during burst                                        |
| R5 = 0                        | accesses.                                                          |
| R6 = 0                        | If $\overline{\text{WAITIN}} = 0$ , add one clock to               |
|                               | DTACK. Since we are not using the                                  |
|                               | WAITIN input it should be tied high                                |
|                               | on the DP8422A.                                                    |
| R7 = 1                        | Select DTACK                                                       |
| R8 = 1                        | Non-Interleaved Mode                                               |
| R9 = X                        |                                                                    |
| C0 = X                        | Select based upon the input                                        |
| C1 = X                        | "DELCLK" frequency. Example: if                                    |
| C2 = X                        | the input clock frequency is 20                                    |
|                               | MHz then choose C0,1,2 = 0,0,0                                     |
| 1                             | (divide by ten, this will give a                                   |
|                               | frequency of 2 MHz). If using the                                  |
|                               | DP8422A over 20 MHz do an initial                                  |
|                               | divide by two externally and then                                  |
|                               | run that output into the DELCLK                                    |
|                               | input and choose the correct                                       |
| 00 - X                        | divider.                                                           |
| C3 = X                        |                                                                    |
| C4 = 0                        | RAS groups selected by "B1". This                                  |
| C5 = 0                        | mode allows two RAS outputs to                                     |
| C6 = 1                        | go low during an access, and<br>allows byte writing 32-bit words.  |
| C7 = 1                        | Column address setup time of 0 ns.                                 |
| C7 = 1<br>C8 = 1              | Row address hold time of 15 ns.                                    |
|                               |                                                                    |
| C9 = 1                        | Delay CAS during write accesses to one clock after RAS transitions |
|                               | low.                                                               |
| B0 = 1                        | Fall-thru latches                                                  |
| B0 = 1<br>B1 = 1              | Access Mode 1                                                      |
| $\overline{\text{ECAS0}} = 0$ | CAS not extended beyond RAS.                                       |
| ECAS0 = 0                     | CAS not extended beyond RAS.                                       |

0 = program with low voltage level

1 = program with high voltage level

X = program with either high or low voltage level (don't care condition)

### NS32532 TIMING CALCULATIONS FOR DESIGN AT 25 MHz WITH 3 WAIT STATES DURING THE NORMAL ACCESSES AND 1 WAIT STATE DURING BURST ACCESSES

- Minimum ADS low setup time to CLOCK high for DTACK logic to work correctly (DP8422A-25 needs 25 ns):
   40 ns (one clock period) 8 ns (PAL16R4D clocked output maximum) = 32 ns
- 2a Minimum time to  $\overline{\text{ADS}}$  low = 40 ns (one clock period) + 2 ns (minimum clocked output delay of PAL16R4D PAL) = 42 ns minimum

2b Minimum address setup time to ADS low (DP8422A-25 needs 14 ns):

42 ns (#2a above) - 8 ns (max time to address valid from BLCK high) - 6.2 ns (74AS244 buffer delay max) = 27.8 ns

3a Minimum CS setup time to CLK high (PAL16R4D needs 10 ns):

40 ns (one clock period) - 8 ns (maximum time to address valid from BCLK high) - 6.2 ns (74AS244 buffer delay maximum) - 9 ns (max 74AS138 decoder) = 16.8 ns

- 3b Minimum CS setup time to ADS low (DP8422A-25 needs 5 ns):
  - a Minimum time to  $\overline{\text{ADS}}$  low (see #2a from above) = 42 ns

b Maximum time to  $\overrightarrow{\text{CONF}}$  ( $\overrightarrow{\text{CONF}}$  is tied to  $\overrightarrow{\text{CS}}$  of the DP8422A) = 20 ns (one half clock period) + 9 ns ( $\overrightarrow{\text{CONF}}$  low from falling clock edge) = 29 ns maximum Therefore:

42 ns (minimum time to  $\overline{\text{ADS}}$  low) - 29 ns (maximum time to  $\overline{\text{CONF}}$  low) = 13 ns

4 Determining t<sub>RAC</sub> during a normal access (RAS access time needed by the DRAM):

160 ns (four clock periods to do the access) - 8 ns (PAL16R4D clocked output) - 29 ns (ADS to RAS low) - 10 ns (NS32532 data setup time) - 7 ns (74F245) = 106 ns

Therefore the  $t_{RAC}$  of the DRAM must be 106 ns or less.

5 Determining t<sub>CAC</sub> during a normal access (CAS access time) and column address access time needed by the DRAM:

160 ns - 8 ns - 10 ns - 7 ns - 75 ns (ADS to CAS low on DP8422A-25, 50 pF spec) - 12 ns [74AS32, 6 ns, plus 6 ns extra, taken from lab data on the 74AS32, for drving a 22 $\Omega$  damping resistor and 150 pF of capacitance associated with driving 16 DRAM CAS inputs (per CAS output)] = 48 ns

Therefore the  $t_{\mbox{CAC}}$  of the DRAM must be 48 ns or less.

6 Determining the nibble mode access time needed during a burst access:

80 ns (two clock periods to do the burst) -20 ns (one half clock period during which  $\overline{CAS}$  is high from the previous access) -10 ns (PAL16R4D combinational output from CLK input falling edge,  $\overline{ENCAS}$ ) -12 ns (74AS32 delay to produce  $\overline{CAS}$  from the  $\overline{ENCAS}$  input, see description from #5) -10 ns (NS32532 data setup time) -7 ns (74F245) = 21 ns

Therefore the nibble mode access time of the DRAM must be 21 ns or less.

7 Maximum time to DTACK1 low (PAL16R6D needs 10 ns setup to BCLK):

40 ns (one clock) - 28 ns (DTACK1 low from CLK high on DP8422A-25) = 12 ns

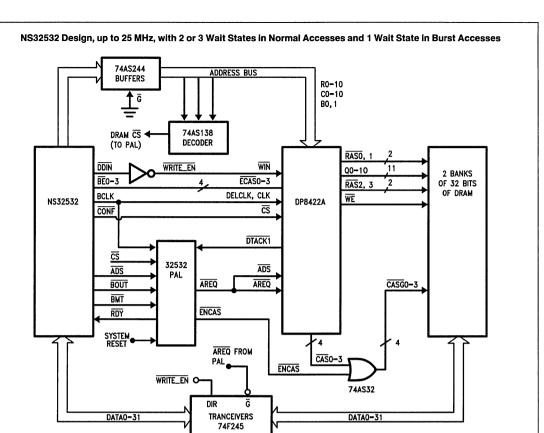
8 Minimum RDY setup time to BCLK (19 ns to BCLK rising edge is needed by the NS32532):

40 ns (one clock period) – 8 ns (PAL16R4D clocked output maximum) = 32 ns

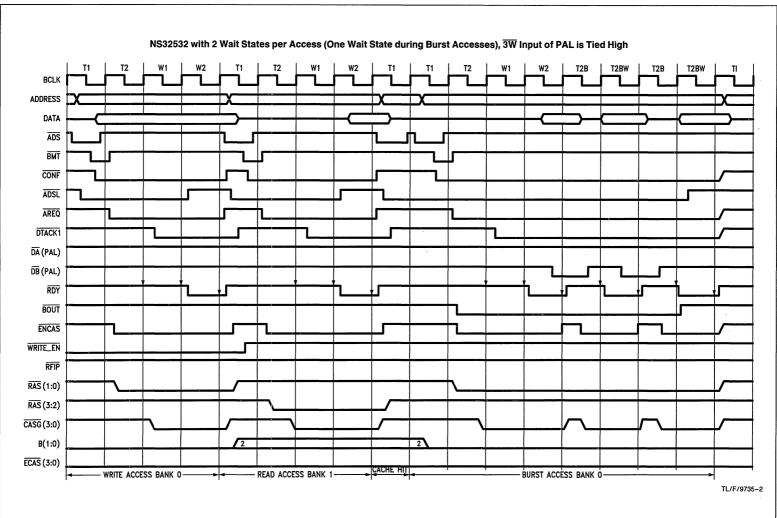
Note: Calculations can be performed for different frequencies by substituting the appropriate values into the above equations.

## **AN-541**

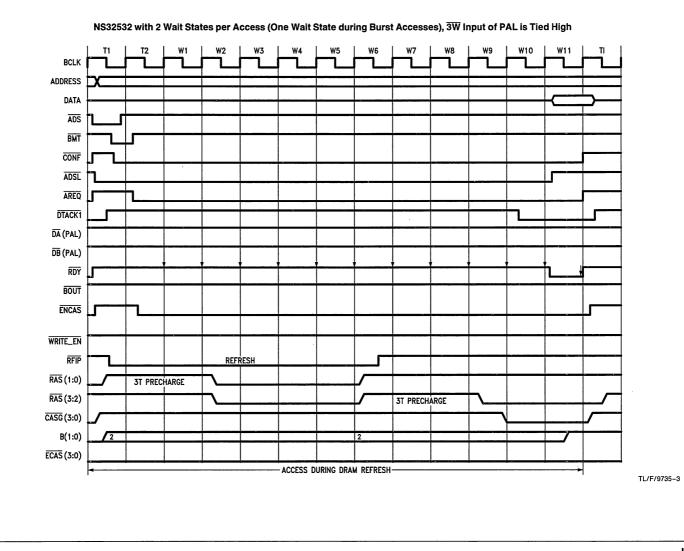
## 5.0 NS32532 DESIGN, PAL EQUATIONS WRITTEN IN NATIONAL SEMICONDUCTOR PLAN FORMAT PAL16R4D BCLK /CS /ADS /BOUT /DTACK /EXRDY /3W CLK /BMT GND /OE NC1 /DB NC2 /RDY /DA /AREQ /ENCAS /ADSL VCC IF (VCC) /ADSL = /ADS +/ADSL\*/CLK +/ADSL\*/BOUT\*/CS +/ADSL\*RDY\*/CS IF (VCC) /ENCAS = /AREQ\*/CS\*DB +/AREQ\*/CLK\*/CS IF (VCC) /DB = /AREQ\*/BOUT\*/RDY\*/CLK + /AREQ\*/BOUT\*/DB\*CLK /AREQ := /ADSL\*/BMT\*/CS +/ADSL\*/AREQ\*/CS /DA := /ADSL\*/AREQ\*/DTACK\*DA\*/3W\*/CS /RDY := /AREQ\*/DTACK\*/ADSL\*/DA\*/CS\*/3W +/AREQ\*/DTACK\*/ADSL\*RDY\*/CS\*3W +/EXRDY Key: Reading PAL equations written in PLAN EXAMPLE EQUATIONS: IF (VCC) /DB = /AREQ\*/BOUT\*/RDY\*/CLK +/AREQ\*/BOUT\*/DB\*CLK This example reads: the output "/DB" will transition low given that one of the following conditions are valid; 1) the output "/AREQ" is low AND the input "/BOUT" is low AND the output "/RDY" is low and the input "CLK" is low, OR 2) the output "/AREQ" is low AND the input "/BOUT" is low AND the output "/DB" is low and the input "CLK" is high.



TL/F/9735-1



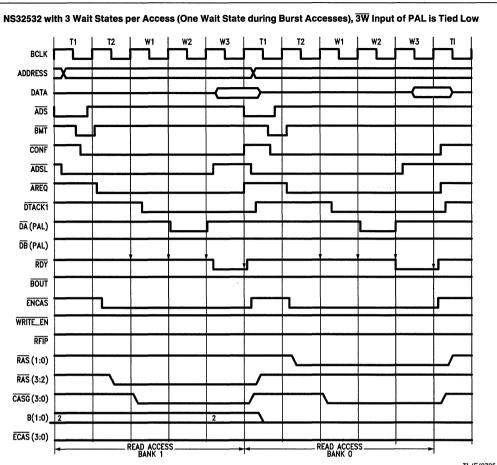
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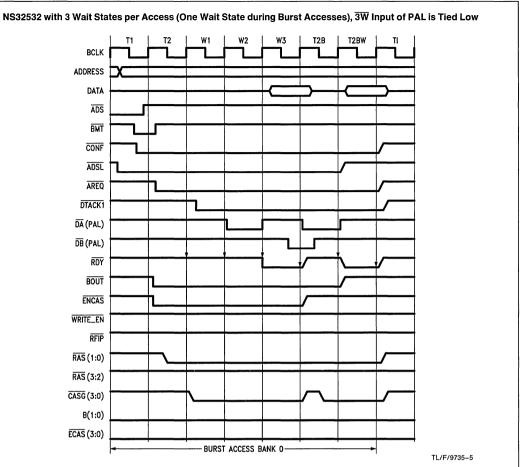
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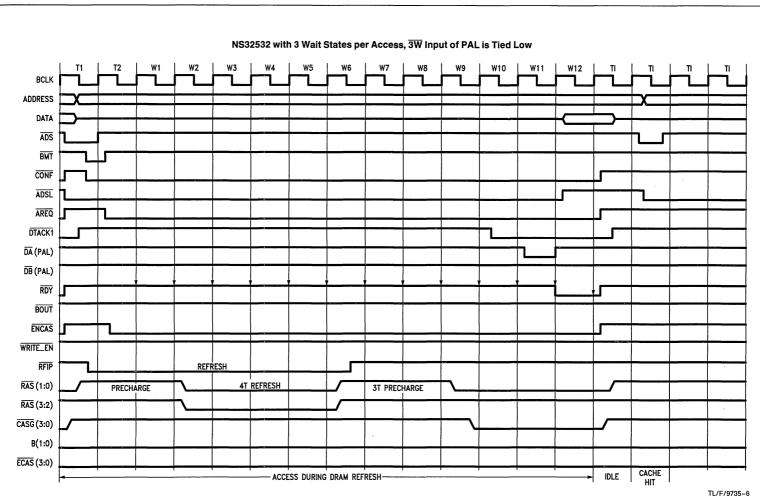




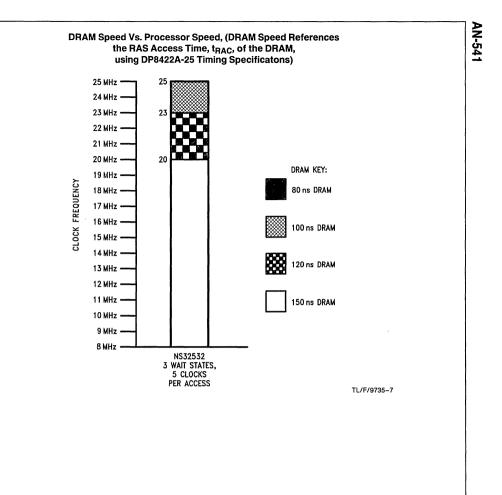
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4-32



### A Dual Access NS32532 Error Detecting and Correcting Memory System

### I. INTRODUCTION

This appendix describes how to interface two NS32532 microprocessors, both synchronous to the same system clock, to a DP8422A DRAM controller and a 74F632 EDAC chip. It is assumed that the reader is already familiar with NS32532, the DP8422A, and the 74F632 modes of operation. The National Semiconductor DP8420A can be used in place of the 74F632, though its timing is slower.

This application note supports the following types of memory accesses:

- Read accesses with 6 wait states inserted (8 clock periods total in the synchronous mode read access), any single bit errors are automatically corrected before sending the data to the CPU (EDAC unit in always correct mode);
- Write accesses with 3 wait states inserted (5 clock periods total in the synchronous mode write access);
- Byte write accesses with 7 wait states inserted (9 clock periods total in the synchronous mode byte write access);
- Burst read accesses with 3 wait states in the burst portion of the access (4 clock periods total per synchronous mode burst read memory access);
- Scrubbing during DRAM refreshes (6 clock periods total during the refresh if no errors, 8 clock periods total during the refresh if any errors), any single bit errors are corrected. The corrected word is then written back to the DRAM.

### II. DESCRIPTION OF 25 MHz DUAL ACCESS NS32532 SYSTEM INTERFACED TO THE DP8422A AND THE 74F632

This design allows two NS32532 microprocessors to access a common error corrected dynamic memory system. The error corrected memory system is implemented using the 74F632 EDAC chip in the always correct mode. Whichever NS32532 accessed the memory last has a higher priority. Both NS32532s are interfaced to the DRAM and allow the DRAM system to support burst mode accesses.

This design is very similar to the 68030 dual access EDAC design and the PALs will be very similar. The reader can refer to that design to see the timing waveforms, block diagrams, and simulations. The only necessary changes to the 68030 design are that the STERMA, B PAL outputs will have to be modified to support the NS32532 RDY inputs, and the AREQ, AREQB outputs of the PALs will have to take ADS,  $\overline{CS}$ , and  $\overline{CONF}$  into consideration (not just  $\overline{ADS}$ ,  $\overline{CS}$  as in the 68030 design). The user should also be careful not to violate the DP8422A parameter #416 (AREQ negated to  $\overline{ADS}$  asserted to guarantee tASR = 0 ns) when generating the AREQ, AREQB PAL outputs.

During read accesses the data is always processed through the EDAC chip (always correct type of system). If a single bit error occurs during a read access this design guarantees correct data to the CPU, but does not write the corrected data back to the DRAM. Single bit soft errors in memory are only corrected (written back to memory) during scrubbing type refreshes. The memory is scrubbed often enough that the probability of accumulating two soft errors in memory is very unlikely. National Semiconductor Application Note 540 Webster (Rusty) Meier, Jr. and Joe Tate



During read accesses the data is always processed through the 74F632 EDAC chip (i.e., the EDAC data buffers are enabled to provide the data to the CPU). The 74F632 is always put into latch and correct mode during read accesses, even though the data from the memory may be correct. This allows CAS to be toggled early (before the CPU has sampled the data), during burst mode accesses, to start accessing the next word of the burst access.

This design drives two banks of DRAM, each bank being 39 bits in width (32 data bits plus 7 check bits) giving a maximum memory capacity of 32 Mbytes of error corrected memory (using 4 Mbit x 1 DRAMs). By choosing a different RAS and CAS configuration mode (see programming mode bits section of DP8422A data sheet) this application can support 4 banks of DRAM, giving a memory capacity of 64 Mbytes (using 4 Mbit x 1 DRAMs, NOTE that when driving 64 Mbytes the timing calculations will have to be adjusted to the greater capacitive load).

The memory banks are interleaved on every four word (32bit word) boundary. This means that the address bit (A4) is tied to the bank select input of the DP8422A (B1).

Address bits A3,2 are tied to the least significant column address inputs (C1,0) to support burst accesses using nibble mode DRAMs.

Address bits A1,0 are used to produce the four byte select data strobes, used in byte reads and writes. If the majority of accesses made by the NS32532 are sequential, the NS32532 can be doing burst accesses most of the time. Each burst of four words can alternate memory banks (address bit A4 tied to DP8422A pin B1), allowing one memory bank to be precharging (RAS precharge) while the other bank is being accessed. This is a higher performance memory system than a non-interleaved memory system (bank select on the higher address bits). Each separate memory access to the same memory bank will generally require extra wait states to be inserted into the CPU access cycles to allow for the RAS precharge time.

The logic shown in this application note forms a complete NS32532 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A. arbitration between Port A, Port B, and refreshing the DRAM;
- B. the insertion of wait states to the processor (Port A and Port B) when needed (i.e., if RAS precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access ... etc.);
- C. performing bytes write and reads to the 32-bit words in memory;
- D. normal and burst access operations.

By making use of the enable input on the 74AS244 buffer, this application allows dual access applications. The addresses and chip select are TRI-STATE through this buffer, the write input ( $\overline{WIN}$ ), lock input ( $\overline{LOCK}$ ) and  $\overline{ECASO-3}$  inputs must also be able to be TRI-STATE (another 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B) the DP8422A allows dual accessing to be performed.

#### III. NS32532 25 MHz DUAL ACCESS EDAC DESIGN: THE EDAC ERROR MONITORING METHOD IN CONJUNCTION WITH THE NS32532 BUS RETRY FEATURE

The NS32532 dual access EDAC system design can use the error monitoring method in conjunction with the NS32532 bus retry feature, instead of the always correct method (design shown in the NS32532 application note). The error monitoring method can yield a slight improvement in system performance.

By using the error monitoring method of error correction single read accesses or the first read access during a burst access can be shortened by one clock period, allowing a synchronous read access to have only 5 wait states inserted, 7 clock periods total (compared to 6 wait states, 8 clock periods total when doing the always correct method). All other types of accesses (burst reads, bytes writes, word writes, refresh scrubbing) will execute in the same number of clock cycles, and in the same manner as described in this application note.

Read accesses can save one wait state because the data from the DRAM memory is assumed to be correct in the error monitoring system design. Therefore the DRAM data is given directly to the CPU instead of running it through the EDAC chip as was done in the always correct method.

In order to do this design it is required that the bus retry feature of the NS32532 and registered transceivers be employed.

The bus retry feature of the NS32532 involves pulling the NS32532 input signal "BRT" low before the end of state T2 or T2B. Given that this is done the NS32532 will complete the bus cycle normally, but will ignore the data read in the case of a read cycle. The CPU will then wait for BRT to transition high before repeating the bus cycle (unless that access is not currently needed by the CPU). This feature is useful for the case where an error is detected in the DRAM data. In this case BRT is brought low until the data from the DRAM is corrected (by the EDAC chip) and written back to the DRAM. BRT is then brought high to continue CPU processing.

Registered transceivers are necessary (in place of the 74F245's shown in the block diagram) during burst mode read accesses because CAS transitions high before the CPU has sampled the DRAM data. The registered transceivers hold the data valid until the CPU samples it during these cases.

A read, read with a single bit error, and burst read access timing are shown at the end of this appendix implementing the error monitoring method. The user can see how these access cycles differ from the always correct method access cycles shown in the 68030 dual access EDAC application note.

### IV. NS32532 25 MHz DUAL ACCESS DESIGN, PRO-GRAMMING MODE BITS

| Programmin<br>Bits                   | g Description                                                                                                                                                                                                                                                                                                                                                          |
|--------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R0 = 1<br>R1 = 1                     | $\overline{\text{RAS}}$ low four clocks, $\overline{\text{RAS}}$ precharge of three clocks                                                                                                                                                                                                                                                                             |
| R2 = 1<br>R3 = 0                     | DTACK1 is chosen. DTACK low first rising CLK edge after access RAS is low.                                                                                                                                                                                                                                                                                             |
| R4 = 0<br>R5 = 0                     | No WAIT states during burst accesses                                                                                                                                                                                                                                                                                                                                   |
| R6 = 0                               | If $\overline{\text{WAITIN}} = 0$ , add one clock to $\overline{\text{DTACK}}$ .<br>WAITIN may be tied high or low in this<br>application depending upon the number of<br>wait states the user desires to insert into the<br>access.                                                                                                                                   |
| R7 = 1                               | Select DTACK                                                                                                                                                                                                                                                                                                                                                           |
| R8 = 1<br>R9 = X                     | Non-interleaved Mode                                                                                                                                                                                                                                                                                                                                                   |
| C0 = 1<br>C1 = X<br>C2 = X           | Selected based upon the input "DELCLK"<br>frequency. Example: if the input clock<br>frequency is 20 MHz, then choose C0,1,2 =<br>0,0,0 (divide by ten, this will give a frequency<br>of 2 MHz). If DELCLK of the DP8422A is over<br>20 MHz do an initial divide by two externally<br>and then run that output into the DELCLK<br>input and choose the correct divider. |
| C3 = X<br>C4 = 0<br>C5 = 0<br>C6 = 1 | RAS groups select by "B1". This mode allows two RAS outputs to go low during an access, and allows byte writing in 32-bit                                                                                                                                                                                                                                              |
| C7 = 1<br>C8 = 1<br>C9 = 1           | words.<br>Column address setup time of 0 ns<br>Row address hold time of 15 ns<br>Delay CAS during write accesses to one<br>clock after RAS transitions low                                                                                                                                                                                                             |
| B0 = 1<br>B1 = 1                     | Fall-thru latches<br>Access mode 1                                                                                                                                                                                                                                                                                                                                     |
| $\overline{\text{ECAS}}0 = 0$        | Non-extend CAS mode                                                                                                                                                                                                                                                                                                                                                    |
|                                      | th low voltage level<br>th high voltage level                                                                                                                                                                                                                                                                                                                          |

X = Program with either high or low voltage level (don't care condition)

### V. NS32532 25 MHz WORST CASE TIMING CALCULATIONS

The worst case access is an access from Port B. This occurs because the time to  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  low is longer for the Port B access than a Port A access, a refresh with scrubbing access, or an access which has been delayed from starting (due to refresh,  $\overline{\text{RAS}}$  precharge time, or the other Port accessing memory).

A. Worst case time to RAS low from the beginning of an access cycle:

40 ns (T1 clock period of NS32532) + 10 ns (PAL16R4D maximum combinational output delay to produce  $\overline{\text{AREQB}}$  + 41 ns (DP8422A-25 parameter #102,  $\overline{\text{AREQ}}$  to  $\overline{\text{RAS}}$  delay maximum) = 91 ns

B. Worst case time to CAS low from the beginning of an access cycle:

 $\frac{40 \text{ ns} + 10 \text{ ns} + 94 \text{ ns}}{\text{AREQB to CAS delay maximum}} = 144 \text{ ns}$ 

C. Worst case time to DRAM data valid:

144 ns (from "B" above, maximum time to  $\overline{\text{CAS}}$ ) +50 ns ( $\overline{\text{CAS}}$  access time "tCAC" for a typical 100 ns DRAM) = 194 ns

- D. Worst case time to data valid on the EDAC data bus: 194 ns (from "C" above) + 7 ns (74AS244 maximum delay) = 201 ns
- E. Worst case time until the error flags are valid from the 74F632:

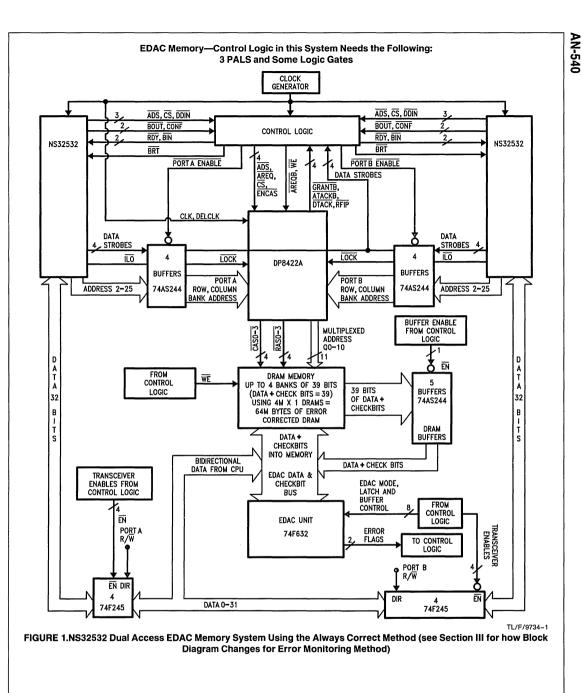
201 ns (from "D" above) + 31 ns (74F632 maximum time to error flags valid) = 232 ns

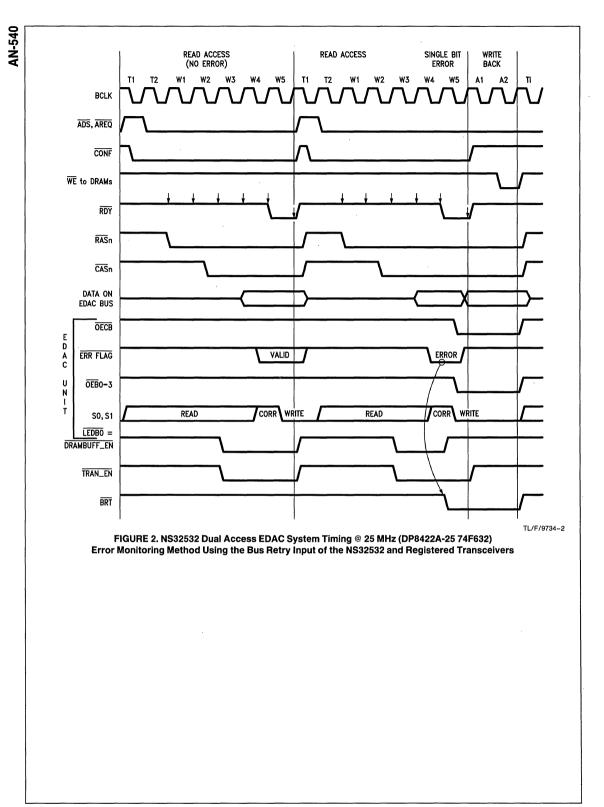
F. Worst case time until corrected data is valid from the 74F632:

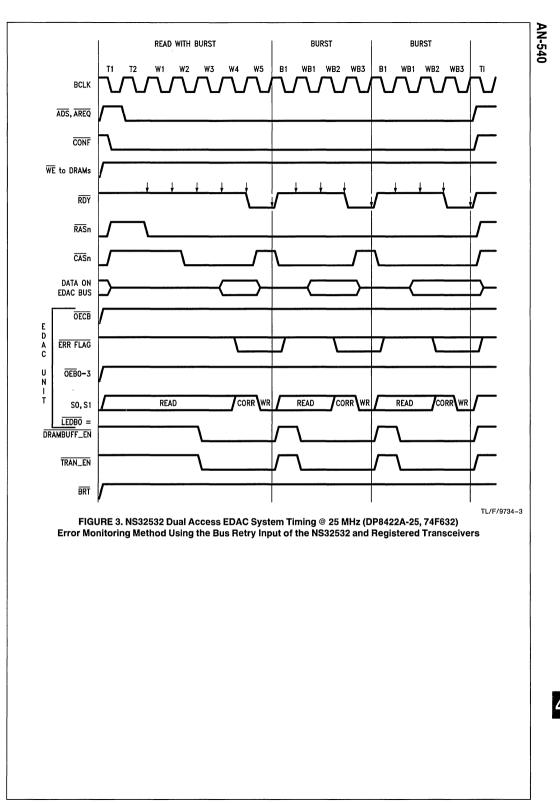
201 ns (from "D" above) + 28 ns (74F632 maximum time from data in to correct data out) = 229 ns

G. Worst case time until corrected data is available at the CPU:

229 ns (from "F" above) + 7 ns (74F245 maximum delay) = 236 ns







### Interfacing the DP8420A/21A/22A to the 68000/008/010

### INTRODUCTION

This application note explains interfacing the DP8420A/21A/22A DRAM controller to the 68000. Three different designs are shown and explained. It is assumed that the reader is familiar with the 68000 access cycles and the DP8420A/21A/22A modes of operation. This application note also applies to the 68010.

### **DESIGN #1 DESCRIPTION**

Design #1 is a simple circuit to interface the 68000 to the DP8420A/21A/22A and up to 32 Mbytes of DRAM. The DP8420A/21A/22A is operated in Mode 1. An access cycle begins when the 68000 places a valid address on the address bus and asserts the address strobe (AS). Chip select (CS) is generated by a 74AS138 decoder. If a refresh or Port B access (DP8422A only) is not in progress, the DP8420A/21A/22A will assert the proper RAS depending on the bank select inputs (B0, B1). After guaranteeing the programmed value of row address hold time the DP8420A/21A/22A will switch the DRAM address (Q0-8. 9. 10) to the column address and assert CAS. By this time. the 74AS245's have been enabled and the DRAMs place their data on the data bus. The DP8420A/21A/22A also asserts DTACK which is used to generate DTACK to the 68000 to complete the access.

If a refresh or Port B access had been in progress, the DP8420A/21A/22A would have delayed the 68000's access by inserting wait states into the access cycle until the refresh or Port B access was complete and the programmed amount of precharge time was met. This circuit can run up to 10 MHz with 0 wait states, with two or more banks. For 10 MHz, zero wait states with one bank, see design #2.

Timing parameters are referenced to the numbers shown in the DP8420A/21A/22A data sheet timing parameters. Numbered times starting with a "\$" refer to the DP8420A/21A/22A timing parameters. Numbered times starting with "#" refer to the 68000 data sheet. Equations have been given to allow the user to calculate timing based on his frequency and application. The clock is at 10 MHz, a multiple of 2 MHz, allowing it to be tied directly to DELCLK. If DELCLK is not a multiple of 2 MHz, ADS to CAS must be recalculated.

### DESIGN #1 TIMING AT 10 MHz AND 8 MHz

| Clock Period | = Tcp10 = 100 ns @ 10 MHz<br>= Tcp8 = 125 ns @ 8 ns                                                            |
|--------------|----------------------------------------------------------------------------------------------------------------|
| \$400b:      | ADS Asserted Setup to CLK High<br>= Clock Period - CLK High to AS Asserted<br>= Tcp10 - #9<br>= 100 ns - 55 ns |
| [            | = 45 ns @ 10 MHz                                                                                               |
|              | = Tcp8 - #9<br>= 125 ns - 60 ns                                                                                |
| [            | = 65 ns @ 8 MHz                                                                                                |

### National Semiconductor Application Note 538 Joe Tate and Rusty Meier



| \$401:          | CS Setup to ADS Asserted                                                                                                                                                                                                                                                                                                   |
|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                 | = 68000 Address to $\overline{AS}$ Max                                                                                                                                                                                                                                                                                     |
|                 | - 74AS138 Decoder                                                                                                                                                                                                                                                                                                          |
|                 | = #11 - Tphl Max                                                                                                                                                                                                                                                                                                           |
|                 | = 20 ns - 9 ns                                                                                                                                                                                                                                                                                                             |
|                 | = 11 ns @ 10 MHz                                                                                                                                                                                                                                                                                                           |
|                 | = #11 — Tphi                                                                                                                                                                                                                                                                                                               |
|                 | = 30 ns - 9 ns                                                                                                                                                                                                                                                                                                             |
|                 | = 21 ns @ 8 MHz                                                                                                                                                                                                                                                                                                            |
| \$407 & \$404:  | Address Valid Setup to ADS Asserted                                                                                                                                                                                                                                                                                        |
|                 | = 68000 Address to $\overline{AS}$ Max                                                                                                                                                                                                                                                                                     |
|                 | = #11 Max                                                                                                                                                                                                                                                                                                                  |
|                 | = 20 ns @ 10 MHz                                                                                                                                                                                                                                                                                                           |
|                 | = #11 Max                                                                                                                                                                                                                                                                                                                  |
|                 | = 30 ns @ 8 MHz                                                                                                                                                                                                                                                                                                            |
|                 |                                                                                                                                                                                                                                                                                                                            |
| \$405:          | ADS Negated Held from CLK High                                                                                                                                                                                                                                                                                             |
| \$405:          | $\overline{\text{ADS}}$ Negated Held from CLK High<br>= 68000 CLK High to $\overline{\text{AS}}$ Asserted Min                                                                                                                                                                                                              |
| \$405:          | ADS Negated Held from CLK High<br>= 68000 CLK High to AS Asserted Min<br>= #10 Min                                                                                                                                                                                                                                         |
| \$405:          | = 68000 CLK High to AS Asserted Min                                                                                                                                                                                                                                                                                        |
| \$405:          | = 68000 CLK High to AS Asserted Min<br>= #10 Min                                                                                                                                                                                                                                                                           |
| \$405:          | = 68000 CLK High to ĀS Asserted Min<br>= #10 Min<br>= 0 ns @ 10 MHz                                                                                                                                                                                                                                                        |
| \$405:<br># 47: | = 68000 CLK High to <del>AS</del> Asserted Min<br>= #10 Min<br>= <b>0 ns @ 10 MHz</b><br>= #10 Min                                                                                                                                                                                                                         |
|                 | = 68000 CLK High to AS Asserted Min<br>= #10 Min<br>= 0 ns @ 10 MHz<br>= #10 Min<br>= 0 ns @ 8 MHz                                                                                                                                                                                                                         |
|                 | = 68000 CLK High to <del>AS</del> Asserted Min<br>= #10 Min<br>= 0 ns @ 10 MHz<br>= #10 Min<br>= 0 ns @ 8 MHz<br>DTACK Setup Time                                                                                                                                                                                          |
|                 | <ul> <li>= 68000 CLK High to AS Asserted Min</li> <li>= #10 Min</li> <li>= 0 ns @ 10 MHz</li> <li>= #10 Min</li> <li>= 0 ns @ 8 MHz</li> <li>DTACK Setup Time</li> <li>= ½ Clock Period</li> </ul>                                                                                                                         |
|                 | <ul> <li>= 68000 CLK High to AS Asserted Min</li> <li>= #10 Min</li> <li>= 0 ns @ 10 MHz</li> <li>= #10 Min</li> <li>= 0 ns @ 8 MHz</li> <li>DTACK Setup Time</li> <li>= ½ Clock Period<br/>- Clock to DTACK Asserted</li> </ul>                                                                                           |
|                 | <ul> <li>= 68000 CLK High to AS Asserted Min</li> <li>= #10 Min</li> <li>= 0 ns @ 10 MHz</li> <li>= #10 Min</li> <li>= 0 ns @ 8 MHz</li> <li>DTACK Setup Time</li> <li>= ½ Clock Period         <ul> <li>Clock to DTACK Asserted</li> <li>= ½ Tcp10 - \$18</li> </ul> </li> </ul>                                          |
|                 | = 68000 CLK High to ĀS Asserted Min<br>= #10 Min<br>= 0 ns @ 10 MHz<br>= #10 Min<br>= 0 ns @ 8 MHz<br>DTACK Setup Time<br>= ½ Clock Period<br>- Clock to DTACK Asserted<br>= ½ Tcp10 - \$18<br>= 50 ns - 28 ns                                                                                                             |
|                 | <ul> <li>= 68000 CLK High to AS Asserted Min</li> <li>= #10 Min</li> <li>= 0 ns @ 10 MHz</li> <li>= #10 Min</li> <li>= 0 ns @ 8 MHz</li> <li>DTACK Setup Time</li> <li>= ½ Clock Period <ul> <li>Clock to DTACK Asserted</li> <li>½ Tcp10 - \$18</li> <li>= 50 ns - 28 ns</li> <li>= 22 ns @ 10 MHz</li> </ul> </li> </ul> |
|                 | = 68000 CLK High to <del>AS</del> Asserted Min<br>= #10 Min<br>= 0 ns @ 10 MHz<br>= #10 Min<br>= 0 ns @ 8 MHz<br>DTACK Setup Time<br>= ½ Clock Period<br>- Clock to DTACK Asserted<br>= ½ Cop10 - \$18<br>= 50 ns - 28 ns<br>= 22 ns @ 10 MHz **Using 8420-25<br>= ½ Tcp8 - \$18                                           |

### **RAS LOW DURING REFRESH**

tRAS

| <ul> <li>Programmed Clock</li> <li>– [(CLK High to Refresh RAS Asserted)</li> <li>– (CLK High to Refresh RAS Negated)]</li> </ul> |
|-----------------------------------------------------------------------------------------------------------------------------------|
| = Tcp10 + Tcp10 - \$55                                                                                                            |
| = 100 ns + 100 ns - 6 ns                                                                                                          |
| = 194 ns @ 10 MHz                                                                                                                 |
| = Tcp8 + Tcp8 - \$55                                                                                                              |
| = 125 ns + 125 ns - 6 ns                                                                                                          |
| = 244 ns @ 8 MHz                                                                                                                  |
|                                                                                                                                   |
|                                                                                                                                   |
|                                                                                                                                   |
|                                                                                                                                   |
|                                                                                                                                   |

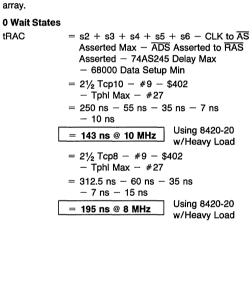
### **RAS PRECHARGE PARAMETERS\*\***

| tRP | <ul> <li>= (Programmed Clocks - 1)</li> <li>- [(AREQ to RAS Negated))</li> <li>- (CLK to RAS Asserted)]</li> <li>= Tcp10 - \$50</li> <li>= 100 ns - 16 ns</li> </ul> |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|     | = 84 ns @ 10 MHz                                                                                                                                                     |
|     | = Tcp8 - \$50<br>= 125 ns - 16 ns                                                                                                                                    |
|     | = 109 ns @ 8 MHz                                                                                                                                                     |

\*\*To gain more precharge program 3t or use design #2.

### tRAC AND tCAC FOR DRAMs

Timing is supplied for the system shown in Figure 1. (see Figures 2, 3 and 4). Since systems and DRAM times vary. the user is encouraged to change the following equations to match his system requirements. Timing has been supplied for systems with 0 or 1 wait state. If DELCLK is not a multiple of 2 MHz, the timing for tRAH and tASC will increase or decrease according to the equations given in the data sheet. The ADS to RAS and ADS to CAS will also have to be changed depending on the capacitance of the DRAM



### 1 Wait State

tRAC

= s2 + s3 + s4 + sw + sw + s5 + s6- CLK to AS Asserted Max - ADS Asserted to RAS Asserted - 74AS245 Delay Max - 68000 Data Setup Min = 31/2 Tcp10 - #9 - \$402 - Tphl Max - #27 = 350 ns - 55 ns - 35 ns - 7 ns - 10 ns Usina 8420-20 = 243 ns @ 10 MHz w/Heavy Load = 31/2 Tcp8 - #9 - \$402 - Tphl Max - #27 = 437.5 ns - 60 ns - 35 ns - 7 ns — 15 ns Using 8420-20 = 320 ns @ 8 MHz w/Heavy Load 0 Wait States = s2 + s3 + s4 + s5 + s6 - CLK to  $\overline{AS}$ Asserted Max - ADS Asserted to CAS Asserted - 74AS245 Delay Max 68000 Data Setup Min = 21/2 Tcp10 - #9 - \$403a - Tphi Max - #27 = 250 ns - 55 ns - 94 ns - 7 ns — 10 ns Using 8420-20 = 84 ns @ 10 MHz w/Heavy Load = 21/2 Tcp8 - #9 - \$403a

— Tphi Max — #27 = 312.5 ns - 60 ns - 94 ns - 7 ns — 15 ns Lising 8420-20

### 1 Wait State

tCAC

tCAC

= s2 + s3 + s4 + sw + sw + s6 - CLKto AS Asserted Max - ADS Asserted to CAS Asserted - 74AS245 Delay Max - 68000 Data Setup Min = 31/2 Tcp10 - #9 - \$403a - Tphi Max - #27

- = 350 ns 55 ns 94 ns - 7 ns - 10 ns
- Using 8420-20 = 184 ns @ 10 MHz w/Heavy Load = 31/2 Tcp8 - #9 - \$403a
- TphI Max #27 = 437.5 ns - 60 ns - 94 ns - 7 ns — 15 ns

= 261 ns @ 8 MHz

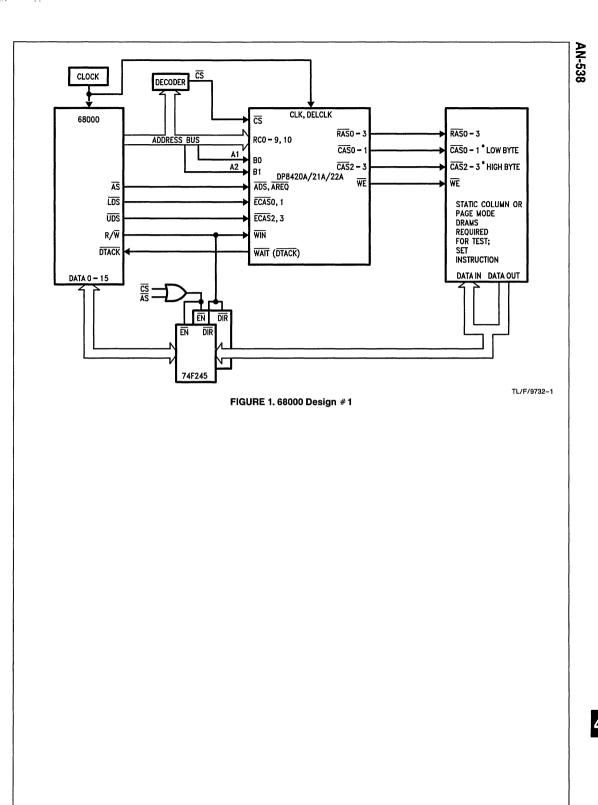
Using 8420-20 w/Heavy Load

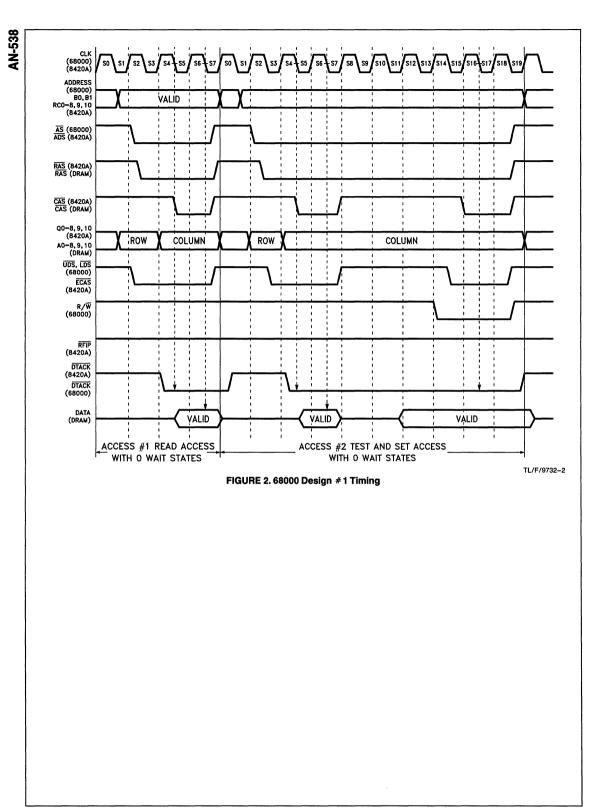
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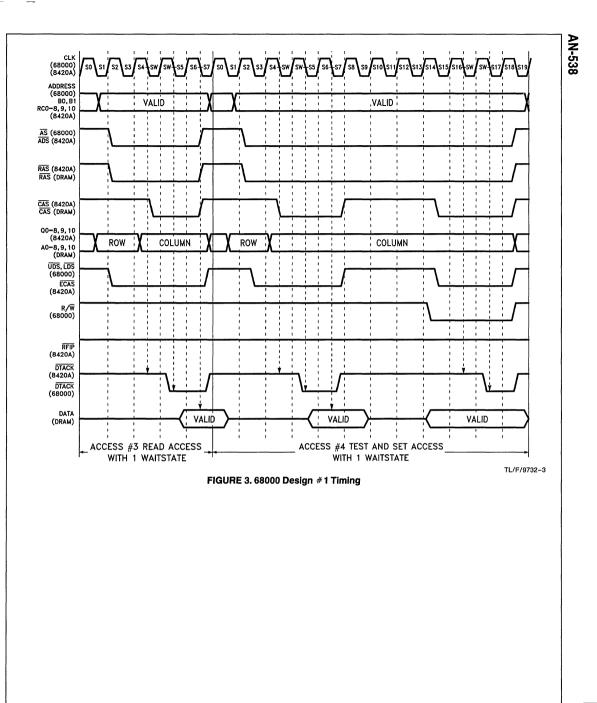
**AN-538** 

|            | Design #1 Programming Bits                    | r       |
|------------|-----------------------------------------------|---------|
| Bits       | Description                                   | Value   |
| R0, R1     | $\overline{RAS}$ Low Time During REFRESH = 2T | R0 = 0  |
|            | RAS Precharge Time = 2T                       | R1 = 1  |
| R2, R3     | DTACK Generation Modes                        | R2 = s  |
|            | for Non-Burst Accesses                        | R3 = s  |
| R4, R5     | DTACK Generation Modes                        | R4 = s  |
|            | for Burst Accesses                            | R5 = s  |
| R6         | Add Wait States with WAITIN                   | R6 = s  |
| R7         | DTACK Mode Select                             | R7 = 1  |
| R8         | Non Interleaved Mode                          | R8 = 1  |
| R9         | Staggered or All RAS REFRESH                  | R9 = u  |
| C0, C1, C2 | Divisor for DELCLK                            | C0 = s  |
|            |                                               | C1 = s  |
|            |                                               | C2 = s  |
| C3         | + 30 REFRESH                                  | C3 = 0  |
| C4, C5, C6 | RAS, CAS Configuration Mode                   | C4 = u  |
|            | *Choose All CAS Mode                          | C5 = u  |
|            |                                               | C6 = u  |
| C7         | Select 0 ns Column Address Setup              | C7 = 1  |
| C8         | Select 15 ns Row Address Setup                | C8 = 1  |
| C9         | CAS is Delayed to the Next Rising             | C9 = 1  |
| н.<br>     | CLK Edge During Writes                        |         |
| B0         | The Row/Column Bank Latches                   | B0 = 1  |
|            | Are Fall Through Mode                         |         |
| B1         | Access Mode 1                                 | B1 = 1  |
| ECAS0      | CAS Not Extended Beyond RAS                   | ECASO = |

u = user defined s = system dependent R3 = 0 for 0 WAIT STATES R2 = 1 R2 = 1 R3 = 0 R6 = 0for 1 WAIT STATE C0 = 1 C1 = 0 C2 = 1 for 10 MHz C0 = 0 C2 = 1 for 8 MHz C1 = 0 R4 = 0 R5 = 0 for 0 WAIT STATES during write portion of test and set R4 = 1 R5 = 1 for 1 WAIT STATE during write portion of test and set

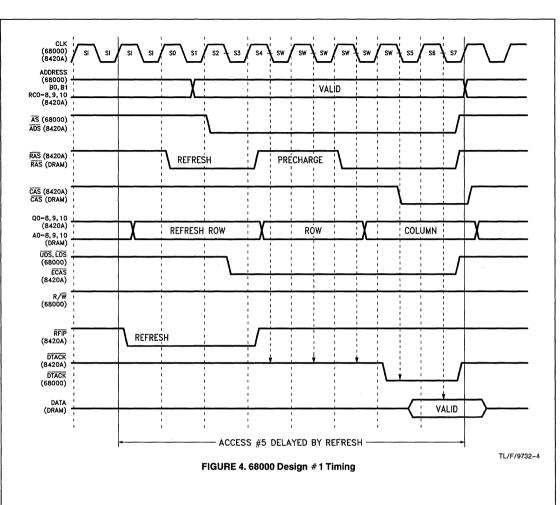






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### **DESIGN #2 DESCRIPTION**

Design #2 differs from Design #1 in that the 68000 can be run up to 12.5 MHz. This design can also run with no wait states at 10 MHz if only one bank of DRAM is being used. A latch must be used with the 68000 address strobe to guarantee the address setup to ADS asserted requirement of the DP8420A/21A/22A. Again, the DP8420A/21A/22A is operated in Mode 1.

An access cycle begins when the 68000 places a valid address on the address bus at the beginning of processor state s1. At processor state s2, the 68000 asserts the address strobe,  $\overline{AS}$ . This signal is qualified with CLK low to set a latch. The output of this latch produces the signal  $\overline{ADS}$  to the DP8420A/21A/22A. When the signal  $\overline{ADS}$  is asserted on the DP8420A/21A/22A, the chip will assert  $\overline{RAS}$ . After guaranteeing the row address hold time, the 8420A/21A/22A will place the column address to the DR4M address bus. After guaranteeing the column address setup time, the DP8420A/21A/22A will assert  $\overline{CAS}$ . After time tCAC has passed, the DRAM will place its data on the data bus. The 8420A/21A/22A will assert the  $\overline{DTACK}$  output allowing the bus cycle to end.

If a refresh of a Port B access had been in progress, the access would have been delayed by inserting wait states in the Port A access cycle.

### DESIGN #2 TIMING AT 12.5 MHz

| Clock Period | = Tcp12 80 ns @ 12.5 MHz                                                                                                                                                                                          |        |
|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| \$400b:      | ADS Asserted Setup to CLK High                                                                                                                                                                                    | RAS    |
|              | <ul> <li>Clock Period + 1/2 Clock Period</li> <li>+ 74AS04 Delay Min + 74AS04</li> <li>Delay Min - Clock to AS Asserted Max</li> <li>- 74AS04 Delay Min - 74AS02</li> <li>Delay Max - 74AS02 Delay Max</li> </ul> | tRAS   |
|              | = Tcp12 + 1/2 Tcp12 + Tphl Min<br>+ Tphl Min - #9 - Tphl Min<br>Tphl Max - Tphl Max                                                                                                                               |        |
|              | - Tphi Max - Tphi Max                                                                                                                                                                                             | RAS    |
|              | = 80 ns + 40 ns + 1 ns + 1 ns - 55 ns<br>- 1 ns - 4.5 ns - 4.5 ns                                                                                                                                                 | tRP    |
|              | = 57 ns @ 12.5 MHz                                                                                                                                                                                                |        |
| \$401:       | CS Setup to ADS Asserted                                                                                                                                                                                          |        |
| φ101.        | ob belup to Abb Asserted                                                                                                                                                                                          |        |
| ¢ lo li      | <ul> <li>Clock Period + 74AS04 Delay Min</li> <li>+ 74AS04 Delay Min + 74AS02</li> <li>Delay Min + 74AS02 Delay Min</li> <li>- 74AS04 Delay Min - Clock</li> <li>to ADR Max - 74AS138 Delay Max</li> </ul>        | \$29b: |
|              | <ul> <li>Clock Period + 74AS04 Delay Min</li> <li>+ 74AS04 Delay Min + 74AS02</li> <li>Delay Min + 74AS02 Delay Min</li> <li>- 74AS04 Delay Min - Clock</li> </ul>                                                | \$29b: |

\$407 & \$404: Address Valid to ADS Asserted = Clock Period + 74AS04 Delay Min + 74AS04 Delay Min + 74AS02 Delay Min + 74AS02 Delay Min Clock to ADR Max - 74AS04 Min = Tcp12 + TphI + TphI + TphI + TphI - #6 - Tphl = 80 ns + 1 ns + 1 ns + 1 ns + 1 ns— 55 ns — 1 ns = 28 ns @ 12.5 MHz \$405: ADS Negated Held from CLK High = Min 74AS04 + Min 74AS02 + Min 74AS02 + Min 74AS04 Min 74AS04 = TphI + TphI + TphI + TphI - TphI = 1 ns + 1 ns + 1 ns + 1 ns - 1 ns= 3 ns @ 12.5 MHz DTACK Setup Time #47: = 1 Clock Period - CLOCK skew (74AS04) Max Clock to DTACK = Tcp12 - TphI Max - \$18 = 80 ns - 5 ns - 28 ns

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### **TAS LOW DURING REFRESH**

| tRAS | <ul> <li>Programmed Clock</li> <li>[(CLK High to Refresh RAS Asserted)</li> <li>(CLK High to Refresh RAS Negated)]</li> </ul> |
|------|-------------------------------------------------------------------------------------------------------------------------------|
|      | = Tcp12 + Tcp12 - \$55                                                                                                        |
|      | = 80 ns + 80 ns - 6 ns                                                                                                        |
|      | = 154 ns @ 12.5 MHz                                                                                                           |

= 47 ns @ 12.5 MHz

### RAS PRECHARGE PARAMETERS

tRP = Programmed Clocks - Clock to 
$$\overline{AS}$$
  
Negated - [(AREQ to RAS Negated)  
- (CLK to RAS Asserted)]  
= Tcp12 + Tcp12 - \$50  
= 80 ns + 80 ns - 16 ns  
= 144 ns @ 12.5 MHz  
\$29b: AREQ Negated Setup to CLK  
= Clock Period + Min CLOCK  
Skew 74AS04 - Max 74AS02  
- Max 74AS02  
= Tcp12 + Tphl + Tphl - Tphl  
= 80 ns + 1 ns - 4.5 ns - 4.5 ns  
= 72 ns @ 12.5 MHz

#### tRAC AND tCAC FOR DRAMs

Timing is supplied for the system shown in Figure 5. (See Figures 6). Since systems and DRAM times vary, the user is encouraged to change the following equations to match his system. Timing has been suppiled for systems with 0 wait states and 1 bank of DRAM and 1 wait state and 4 banks of DRAM. If DELCLK is not a multiple of 2 MHz, the times of tRAH and tASC will increase or decrease according to the equations given in the data sheet. The ADS to RAS and ADS to CAS will also have to be changed depending on the capacitance of the DRAM array.

#### TRAC

0 wait states \* does not use transceivers \* tRAC = s2 + s3 + s4 + s5 + s6 - 74AS02Max - 74AS02 Max - Clock to AS Max - ADS to RAS - Data Setup = 21/3 Tcp12 - Tphi - Tphi - #9 - \$402 - #27 = 200 - 4.5 ns - 4.5 ns - 55 ns - 25 ns - 10 ns \*\*Using 8420-25 = 101 ns @ 12.5 MHz w/Light Load

1 wait state \* uses transceivers \*

= s2 + s3 + s4 + sw + sw + s5 + s6tRAC - 74AS02 Max - 7AS02 Max - Clock to  $\overline{\text{AS}}$  Max  $-\overline{\text{ADS}}$  to  $\overline{\text{RAS}}$  - 74AS245 Delay - Data Setup = 31% Tcp12 - TphI - TphI - #9 - \$402 - Tphl - #27 = 280 ns - 4.5 ns - 4.5 ns - 55 ns - 29 ns - 7 ns - 10 ns = 170 ns @ 12.5 MHz **†CAC** 

0 wait states \* does not use transceivers \*

```
tCAC
             = s2 + s3 + s4 + s5 + s6 - 74AS02
               Max - 74AS02 Max - Clock to AS
               Max - ADS Asserted to CAS

Data Setup

             = 21/2 Tcp12 - Tphi - Tphi - #9
                - $403a - #27
             = 200 ns - 4.5 ns - 4.5 ns - 55 ns
                - 75 ns - 10 ns
                                   *Using 8420-25
             = 51 ns @ 12.5 MHz
                                   w/Light Load
```

1 wait state \* uses transceivers \*

```
tCAC
             = s2 + s3 + s4 + sw + sw + s5 + s6
                - 74AS02 Max Delay - 74AS02 Max
               Delay - Clock to AS Max - ADS
               Asserted to CAS - 74AS245 Data Setup
             = 31/2 Tcp12 - TphI - TphI - #9
                - $403a - Tphl - #27
             = 280 ns - 4.5 ns - 4.5 ns - 55 ns
               - 75 ns - 7 ns - 10 ns
             = 124 ns @ 12.5 MHz
```

#### **DESIGN #2, 0 WAIT STATES DURING WRITE ACCESS**

Design #2 can be modified to allow 0 wait states during writes. To accomplish this, the chip must be programmed with the same value except that bits R2, R3 and R6 are changed to:

R2 = 0DTACK of 0T from RAS

```
R3 = 0
```

R6 = 0Hold off DTACK 1 extra clock period

The hardware must be modifed. The signal R/W from the 68000 is inverted and tied to the 8420 signal WAITIN. This ensures that a wait state will only be asserted during read accesses (see Figure 6).

0 waits during write access timing

#### RAS Low Time

| tRP | = Max <del>AS</del> Low - ½ Clock Period<br>- 74AS02 Delay - 74AS02 Delay<br>+ 74AS02 Delay + 74AS02 Delay<br>- [( <del>ADS</del> Asserted to <del>RAS</del> ) - ( <del>AREQ</del> |
|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|     | Negated to RAS Negated)]                                                                                                                                                           |
|     | = #14 - ½ Tcp12 - Tphl - Tphl + Tphl<br>+ Tphl - \$52                                                                                                                              |
|     | = 160 ns - 40 ns - 0 ns                                                                                                                                                            |
|     | = 120 ns @ 12.5 MHz                                                                                                                                                                |

**CAS** Low Time

tCP

= s2 + s3 + s4 + s5 + s6 - Max CLK to AS - 74AS02 - 74AS02 - Max  $\overline{AS}$  to  $\overline{CAS}$  + Min CLK to  $\overline{DS}$ + Min ECAS to CAS = 21/2 Tcp12 - #9 - Tphi - Tphi

$$- $403a + #12 + $14$$
  
= 200 ns - 55 ns - 4.5 ns - 4.5 ns  
- 82 ns + 0 ns + 0 ns

|            | Design #2 Programming Bits                                  |                               |
|------------|-------------------------------------------------------------|-------------------------------|
| Bits       | Description                                                 | Value                         |
| R0, R1     | RAS Low Time = 2T<br>RAS Precharge Time = 2T                | R0 = 0<br>R1 = 1              |
| R2, R3     | DTACK Generation Modes<br>for Non-Burst Accesses            | R2 = 0<br>R3 = 1              |
| R4, R5     | DTACK Generation Modes<br>for Burst Accesses                | R4 = 0<br>R5 = 1              |
| R6         | Add Wait States with WAITIN                                 | R6 = 0                        |
| R7         | DTACK Mode Select                                           | R7 = 1                        |
| 78         | Non Interleaved Mode                                        | R8 = 1                        |
| 79         | Staggered or All RAS REFRESH                                | R9 = u                        |
| C0, C1, C2 | Divisor for DELCLK                                          | C0 = u $C1 = u$ $C2 = u$      |
| 3          | + 30 REFRESH                                                | C3 = 0                        |
| C4, C5, C6 | RAS, CAS Configuration Mode<br>*Choose All CAS Mode         | C4 = u $C5 = u$ $C6 = u$      |
| 77         | Select 15 ns Column Address Setup                           | C7 = 1                        |
| 28         | Select 15 ns Row Address Setup                              | C8 = 1                        |
| 29         | CAS is Delayed to the Next Rising<br>CLK Edge During Writes | C9 = 1                        |
| 30         | The Row/Column Bank Latches<br>Are Fall Through Mode        | B0 = 1                        |
| B1         | Access Mode 1                                               | B1 = 1                        |
| ECASO      | CAS Not Extended Beyond RAS                                 | $\overline{\text{ECASO}} = 0$ |

#### u = user defined

and the second second

\*see previous page for 0 WAIT STATES during writes

\_\_\_\_\_

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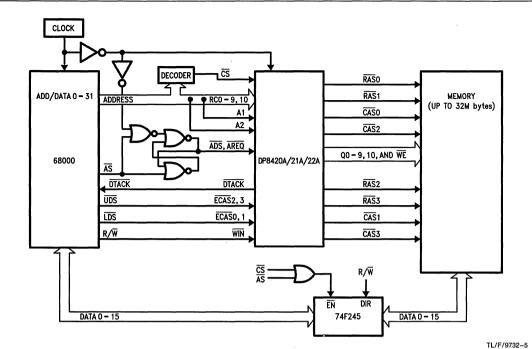


FIGURE 5. 68000 Design #2 up to 12.5 MHz

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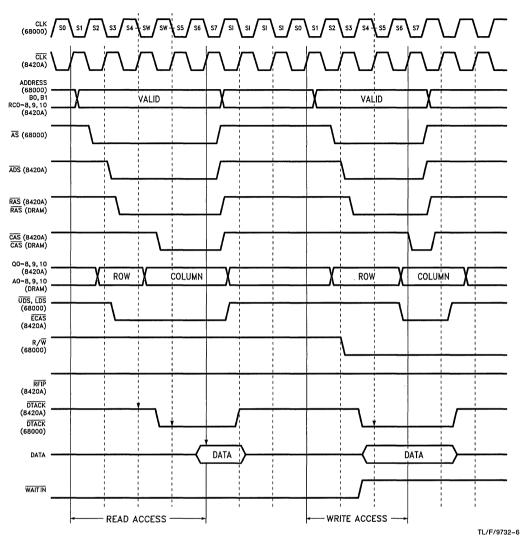


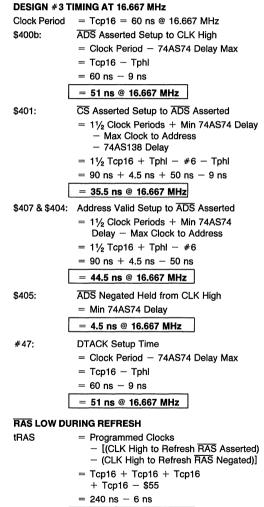
FIGURE 6. Design #2 Timing with Zero Wait States during Writes

4

#### **DESIGN #3 DESCRIPTION**

Design #3 is a simple circuit to interface the 68000 running @ 16 MHz to the DP8420A/21A/22A and up to 32 Mbytes of DRAM. The DP8420A/21A/22A is operated in Mode 1. An access cycle begins when the 68000 places a valid address on the address bus and asserts  $\overline{AS}$ .  $\overline{AS}$  is then clocked with a 74AS74 flip-flop. The output of the flip-flop is used to produce  $\overline{ADS}$  to the DP8420A/21A/22A.

Chip Select ( $\overline{CS}$ ) is generated by a 74AS138 decoder. If a refresh or Port B access had been in progress, the 8420A/21A/22A would hold off the access by inserting wait states in the access cycle. The DP8420A/21A/22A will place the row address on the DRAM's address bus and assert  $\overline{RAS}$ . After guaranteeing the row address hold time, tRAH, the DP8420A/21A/22A will place the column address on the DRAM's address bus and assert  $\overline{CAS}$ .



tRP

```
    = (Programmed Clocks - 1) -
[(AREQ to RAS Negated) -
(CLK to RAS Asserted)]
    = Tcp16 + Tcp16 - $50
    = 120 ns - 16 ns
```

= 104 ns @ 16.667 MHz

#### **RAS** PRECHARGE PARAMETERS

```
tRP
```

Programmed Clocks - Clock to AS
 Negated - [(AREQ to RAS Negated)
 - (CLK to RAS Asserted)]

#### tRAC AND tCAC FOR DRAMs

Timing is supplied for the system shown in *Figure 7*. Since system and DRAM times vary, the user is encouraged to change the following equations to match his system requirements. Timing has been supplied for systems with 2 wait states. If DELCLK is not a multiple of 2 MHz, the timing for tRAH and tASC will increase or decrease according to the times given in the data sheet. The ADS to RAS and ADS to CAS will also have to be changed depending on the capacitance of the DRAM array.

1 wait state \* using 1 BANK with no transceivers

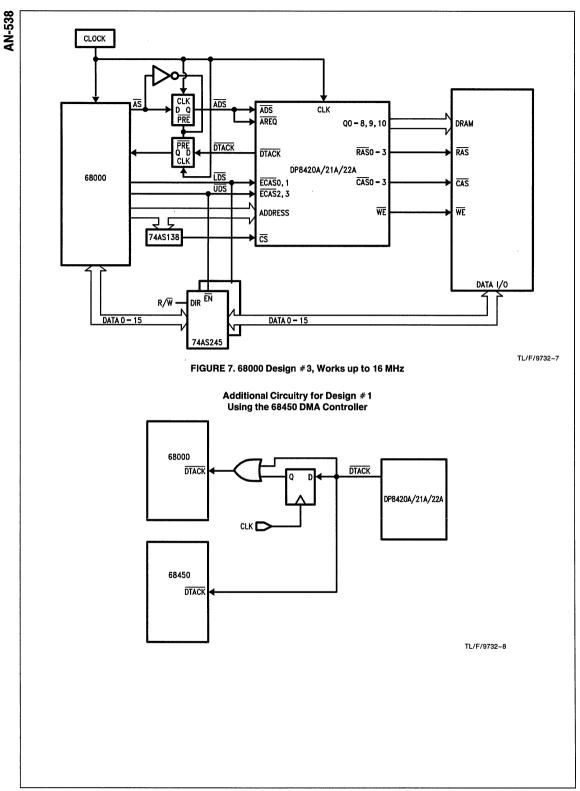
| i wali state  | using I DANK with no transceivers                                                                |
|---------------|--------------------------------------------------------------------------------------------------|
| tRAC          | = s4 + sw + sw + s5 + s6 - 74AS74<br>Delay - ADS to RAS - Data Setup                             |
|               | = 21/2 Tcp16 - Tphl - \$402 - #27                                                                |
|               | = 150 ns - 9 ns - 25 ns - 10 ns                                                                  |
|               | = 106 ns @ 16.667 MHz Using 8420-25<br>w/Light Load                                              |
| 2 wait states | * uses 4 banks with tranceivers *                                                                |
| tRAC          | = s4 + sw + sw + sw + sw + s5 + s6<br>- 74AS74 Delay - ADS to RAS<br>- Data Setup - Transceivers |
|               | = 3½ Tcp16 - Tphl - \$402<br>- #27 - Tphl                                                        |
|               | = 210 ns - 9 ns - 29 ns<br>- 10 ns - 7 ns                                                        |
|               |                                                                                                  |

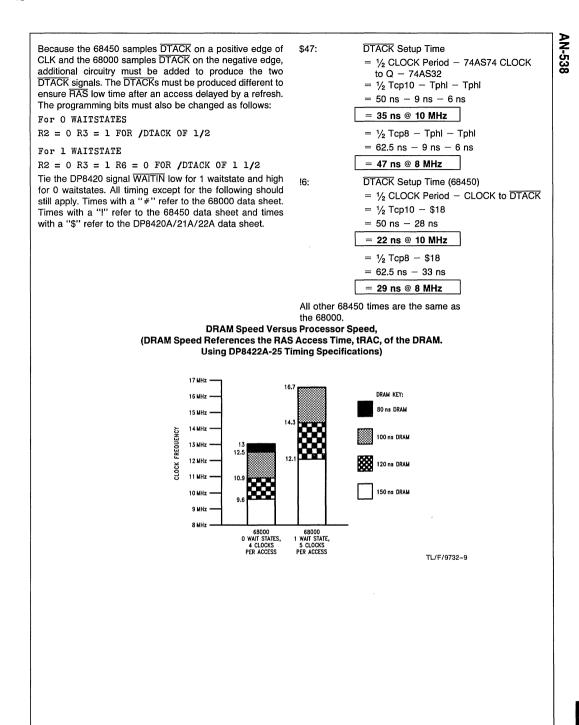
= 155 ns @ 16.667 MHz

| <ul> <li>− Data Setup</li> <li>= 2½ Tcp16 −</li> </ul> | w + s5 + s6<br>elay - ADS to CAS<br>Tphl - \$403a - #27<br>s - 75 ns - 10 ns<br>IHz | 2 wait states '<br>tCAC<br>ogramming Bits | = s4 + s - 74A3 - Data = 31/2 Tcp - #27 = 210 ns - 10 n | nks with transceivers *<br>w + sw + sw + sw + s5 + s6<br>S74 Delay - ADS to CAS<br>setup - Transceiver<br>p16 - TphI - \$403a<br>- TphI<br>- 9 ns - 82 ns<br>s - 7 ns<br>@ 16 MHz |
|--------------------------------------------------------|-------------------------------------------------------------------------------------|-------------------------------------------|---------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bits                                                   |                                                                                     | ription                                   |                                                         | Value                                                                                                                                                                             |
| R0, R1                                                 | RAS Low Time =<br>RAS Precharge 1                                                   | = 2T                                      |                                                         | R0 = 0<br>R1 = 1                                                                                                                                                                  |
| R2, R3                                                 | DTACK Generati<br>for Non-Burst Ac                                                  |                                           |                                                         | R2 = 1<br>R3 = 0                                                                                                                                                                  |
| R4, R5                                                 | DTACK Generati<br>for Burst Access                                                  |                                           |                                                         | R4 = u<br>R5 = u                                                                                                                                                                  |
| R6                                                     | Add Wait States with WAITIN                                                         |                                           | R6 = u                                                  |                                                                                                                                                                                   |
| R7                                                     | DTACK Mode Select                                                                   |                                           | R7 = 1                                                  |                                                                                                                                                                                   |
| R8                                                     | Non Interleaved                                                                     | Node                                      |                                                         | R8 = 1                                                                                                                                                                            |
| R9                                                     | Staggered or All                                                                    | RAS REFRESH                               |                                                         | R9 = u                                                                                                                                                                            |
| C0, C1, C2                                             | Divisor for DELC<br>(+8 for 16 MHz)                                                 | _K                                        |                                                         | C0 = 0<br>C1 = 1<br>C2 = 0                                                                                                                                                        |
| C3                                                     | + 30 REFRESH                                                                        |                                           |                                                         | C3 = 0                                                                                                                                                                            |
| C4, C5, C6                                             | RAS, CAS Config<br>*Choose All CAS                                                  |                                           |                                                         | C4 = u $C5 = u$ $C6 = u$                                                                                                                                                          |
| C7                                                     | Select 15 ns Colu                                                                   | ımn Address Setup                         |                                                         | C7 = 1                                                                                                                                                                            |
| C8                                                     | Select 15 ns Row Address Setup                                                      |                                           | C8 = 1                                                  |                                                                                                                                                                                   |
| C9                                                     | CAS is Delayed t<br>CLK Edge During                                                 | 0                                         |                                                         | C9 = 1                                                                                                                                                                            |
| BO                                                     | The Row/Column<br>Are Fall Through                                                  |                                           |                                                         | B0 = 1                                                                                                                                                                            |
| B1                                                     | Access Mode 1                                                                       |                                           |                                                         | B1 = 1                                                                                                                                                                            |
| ECAS0                                                  | CAS Not Extende                                                                     | ed Beyond RAS                             |                                                         | $\overline{\text{ECASO}} = 0$                                                                                                                                                     |

u = user defined

\*see previous page for 0 WAIT STATES during writes





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## Interfacing the DP8422A to the 68000-16 (Zero Wait State Burst Mode Access)

#### INTRODUCTION

This application note describes interfacing the DP8422A DRAM controller (also applicable to DP8420A/21A) to the 68000 (16 MHz) with slower memories. This design is based upon burst mode access by holding  $\overrightarrow{\text{RAS}}$  low and toggling  $\overrightarrow{\text{CAS}}$ . It is assumed that the user is familiar with the DP8422A and 68000 mode operations.

#### **DESIGN DESCRIPTION**

This design consists of the DP8422A DRAM controller, a PAL (20R4D), and a page detector (ALS6311). This design accommodates four banks of DRAM, each bank being 16 bits in width, giving maximum memory capacity of either 2 Mbytes (using 256k x 4 light load DRAMs) or 8 Mbytes (using 1M x 1 DRAMs). The schematic diagram of interfacing DP8422A to the 68000 is shown in *Figure 1*. The DP8422A is operated in Mode 1. An access cycle begins when the 68000 places a valid address on the address bus and asserts the Address Strobe ( $\overline{AS}$ ) if a refresh or Port B access (DP8422A only) is not in progress. The proper RAS and CAS will be asserted respectively, depending upon programming bits C6, C5, and C4 for RAS and CAS configuration after guaranteeing the programmed value of row address hold time and the column address setup time.

The High Speed Access (HSA) output signal of page detector indicates whether the current access is in the same page as previous access or not.  $\overline{\text{ADS}}$  (AREQ) is kept low if the current access is in the page, otherwise  $\overline{\text{ADS}}$  (AREQ) will be forced to go high to terminate the burst access. Internal refresh logic automatically generates refresh request every 15  $\mu$ s. Since the 256k x 4 DRAM data input and output signals can be controlled by the Output Enable ( $\overline{\text{OE}}$ ). Transceivers (F245) could be eliminated from this design if 256k x 4 DRAM light load DRAM were used. The timing diagrams are shown in *Figure 2* and *Figure 3*.

#### **DP8422A PROGRAMMING BITS**

#### u = user defined

| Programming<br>Bits |         | Description                           |          |
|---------------------|---------|---------------------------------------|----------|
| R0,R1               | = 0,1   | RAS high and low times                |          |
| R2,R3               | — u,u   | DTACK generation mode                 | tCAC (no |
| R4,R5               | = u,u   | for nonburst access                   |          |
|                     |         | for burst access                      |          |
| R6                  | = 0     | Add wait states if WAITIN is low      |          |
| R7                  | = 1     | DTACK mode select                     |          |
| R8                  | = 1     | Noninterleave mode                    |          |
| R9                  | = u     | All RAS's or staggered refresh select |          |
| C0,C1,C2            | = 0,1,0 | Refresh clock divisor select          | tAA (non |
| C3                  | = 0     | Refresh clock divider select          |          |
| C4,C5,C6            | = u,u,u | RAS and CAS configuration mode        |          |
| C7                  | = 1     | tASC mode select                      |          |
| C8                  | = 1     | tRAH mode select                      |          |
| C9                  | = u     | Delay CAS during write                |          |
|                     |         | access mode select                    |          |
|                     |         |                                       |          |

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| Programming<br>Bits |     | Description                    |
|---------------------|-----|--------------------------------|
| B0                  | = 1 | Fall through mode              |
| B1                  | = 1 | Mode 1 access                  |
| ECAS0               | = 1 | Extend CAS and refresh request |

#### **DESIGN TIMING PARAMETERS**

Timing parameters are referenced to the numbers shown in the DP8422A data sheet timing parameters. Numbered times starting with a "\$" refer to DP8422A timing parameters. Numbered times starting with a "#" refer to 68000 timing parameters.

```
16 MHz Tcp = 62.5 ns
```

\$400b: ADS asserted setup to CLK

```
Tcp-PAL tCLK max.
```

```
= 62.5 ns-8 ns
```

```
= 54.5 ns
```

- \$401: CS setup to ADS asserted
  - 2 Tcp #6  $\overline{\text{CLK}}$  to Address valid PAL tp max.
  - = 125 ns-55 ns-10 ns

```
= 60 ns
```

- #47: DTACK (68000) low setup to CLK low
  - Tcp-\$18 CLK to DTACK (DP8422A)
    - asserted PAL tp max. = 62.5 ns - 28 ns - 10 ns
    - = 24.5 ns (DP8422A-25)
    - = 62.5 ns-33 ns-10 ns
      - (DP8422A-20)

#### I. LIGHT LOAD TIMING

= 19.5 ns

tRAC (nonburst access):

| •        |                                                                 |                |
|----------|-----------------------------------------------------------------|----------------|
|          | 3 Tcp-PAL tCLK max\$402 Al<br>low-#27 data setup-F245 Tran      |                |
|          | = 187.5 ns-8 ns-25 ns-7 ns-                                     | -6 ns          |
|          | = 141.5 ns                                                      | (DP8422A-25)   |
|          | = 187.5 ns-8 ns-30 ns-7 ns-                                     | 6 ns           |
|          | = 136.5 ns                                                      | (DP8422A-20)   |
| CAC (noi | nburst access):                                                 |                |
|          | 3 Tcp-PAL tCLK max\$403a<br>CAS low-#27 data setup-F245<br>max. |                |
|          | = 187.5 ns-8 ns-75 ns-7 ns-                                     | -6 ns          |
|          | = 91.5 ns                                                       | (DP8422A-25)   |
|          | = 187.5 ns-8 ns-86 ns-7 ns-                                     | 6 ns           |
|          | = 80.5 ns                                                       | (DP8422A-20)   |
| AA (nont | ourst access):                                                  |                |
|          | 3 Tcp-PAL tCLK max\$417 A                                       | DS low to Col- |
|          | umn Address valid-#27 data<br>Transceiver tp max.               | a setup – F245 |
|          | = 187.5 ns-8 ns-69 ns-7 ns-                                     | -6 ns          |
|          | = 97.5 ns                                                       | (DP8422A-25)   |
|          | = 187.5 ns-8 ns-83 ns-7 ns-                                     | 6 ns           |
|          | = 83.5 ns                                                       | (DP8422A-20)   |
|          |                                                                 |                |

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tCAC (burst access):  
2.5 Tcp 
$$\rightarrow$$
 9 CLK high to  $\overline{DS}$  low max.  $\rightarrow$  PAL tp  
max.  $\rightarrow$  \$14 ECAS low to CAS low max.  $\rightarrow$  #27  
data setup  $-F245$  Transceiver tp max.  
= 156 ns  $\rightarrow$  40 ns  $\rightarrow$  10 ns  $-20$  ns  $\rightarrow$  7  $\rightarrow$  6 ns  
= 73 ns (DP8422A-25)  
= 156 ns  $\rightarrow$  40 ns  $\rightarrow$  10 ns  $-23$  ns  $\rightarrow$  7 ns  $\rightarrow$  6 ns  
= 70 ns (DP8422A-20)  
tAA (burst access):  
3 Tcp  $\rightarrow$  # 6 CLK low to Address valid max.  $-$  \$26  
Address valid to Q max.  $-$  #27 data  
setup  $-F245$  Transceiver tp max.  
= 187.5 ns  $\rightarrow$  5 ns  $-26$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 98.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  5 ns  $-26$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 98.5 ns (DP8422A-20)  
**II. HEAVY LOAD TIMING**  
**ITRAC** (nonburst access):  
3 Tcp  $-PAL$  tCLK max.  $-$ \$402 ADS low to RAS  
low  $-$  #27 data setup  $-F245$  Transceiver tp max.  
= 187.5 ns  $\rightarrow$  8 ns  $-29$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 137.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-29$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 137.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-29$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 137.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-29$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 137.5 ns  $\rightarrow$  8 ns  $-29$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 137.5 ns  $\rightarrow$  8 ns  $-29$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 137.5 ns  $\rightarrow$  8 ns  $-29$  ns  $-7$  ns  $\rightarrow$  6 ns  
= 137.5 ns  $\rightarrow$  8 ns  $-92$  ns  $-7$  ns  $-6$  ns  
= 137.5 ns  $\rightarrow$  8 ns  $-92$  ns  $-7$  ns  $-6$  ns  
= 84.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-94$  ns  $-7$  ns  $-6$  ns  
= 72.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-94$  ns  $-7$  ns  $-6$  ns  
= 72.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-92$  ns  $-7$  ns  $-6$  ns  
= 74.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-92$  ns  $-7$  ns  $-6$  ns  
= 74.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-92$  ns  $-7$  ns  $-6$  ns  
= 74.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-92$  ns  $-7$  ns  $-6$  ns  
= 74.5 ns (DP8422A-25)  
= 187.5 ns  $\rightarrow$  8 ns  $-92$  ns  $-7$  ns  $-6$  ns  
= 74.5 ns (DP8422A-25)  
= 186 ns  $\rightarrow$  0 ns  $-10$  ns  $-27$  ns  $-7$  ns  $-6$  ns  
= 66 ns (DP8422A-25)  
= 156 ns  $-40$  ns  $-10$  ns  $-27$  ns  $-7$  ns  $-6$  ns  
= 66 ns (DP8422A-25)  
= 156 ns  $-40$  ns  $-10$  ns  $-27$  ns  $-7$  ns  $-6$  ns  
= 62 ns (DP8422A-20)

tAA (burst access):

3 Tcp - #6 CLK low to Address valid max.-\$26 Address valid to Q max.-#27 data setup-F245 Transceiver tp max. = 187.5 ns-5 ns-35 ns-7 ns-6 ns = 89.5 ns (DP8422A-25)

= 187.5 ns - 5 ns - 38 ns - 7 ns - 6 ns

= 86.5 ns (DP8422A-20)

#### 68KPAL (PAL20R4D) EQUATIONS

The Boolean entry operators are listed as:

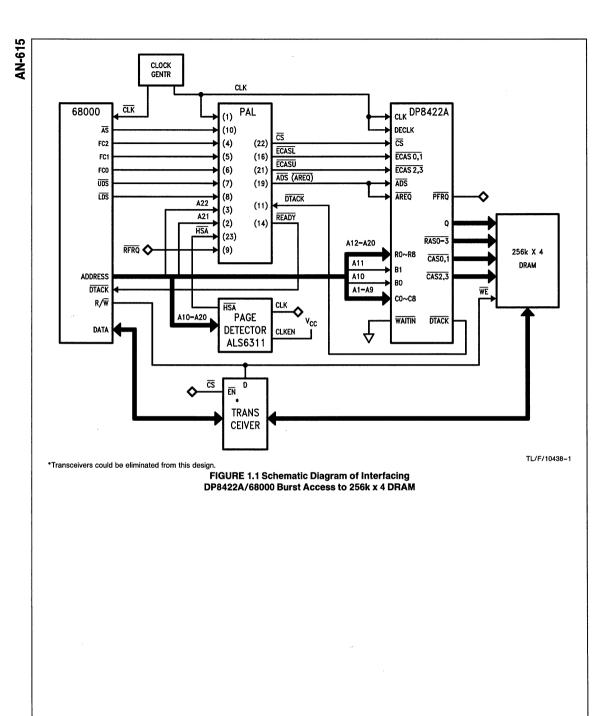
- ":=" Replaced by (after clock)
- "=" Equality
- "\*" AND
- "+" OR
- "/" Complement
- "~" Active low

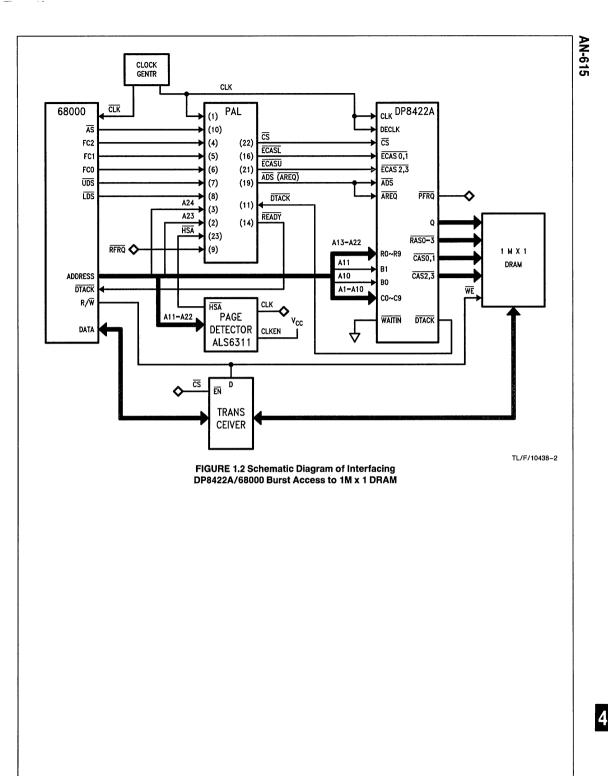
The brief explanation of PAL output signals

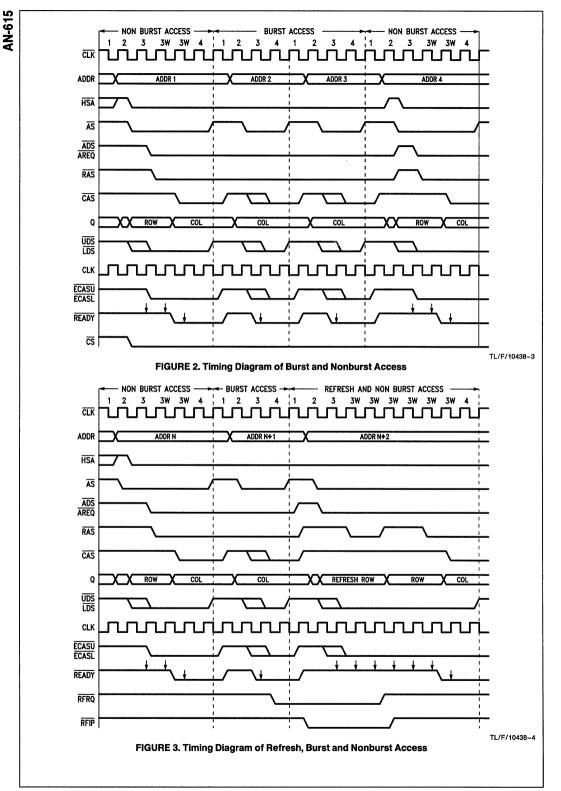
- CS~ This combinational output signal is Chip Select.
- CSD~ This sequential output signal is Chip Select Delayed by one clock.
- ADS~ This sequential output signal is Address Strobe (also used as an Access Request, AREQ, to DP8422A).
- READY~ This combinational output signal is Data Ready.
- ECASU~ This combinational output signal is to select upper byte.
- ECASL~ This combinational output signal is to select lower byte.

Inputs: CLK, A21, A22, FC2, FC1, FC0, UDS  $\sim$  , LSD  $\sim$  , RFRQ  $\sim$  , AS  $\sim$  , DTACK  $\sim$  , HSA  $\sim$ 

Note: Address inputs such as A21 and A22, are system dependent.







## Interfacing the DP8420A/21A/22A to the 68020

#### INTRODUCTION

This application note explains interfacing the DP8420A/21A/22A DRAM controller to the 68020 microprocessor. Three different designs are shown and explained. It is assumed that the reader is already familiar with the 68020 access cycles and the DP8420A/21A/22A modes of operation.

#### **DESIGN #1 DESCRIPTION**

Design #1 is a simple circuit to interface the 68020 to the DP8420A/21A/22A and up to 64 Mbytes of DRAM. T DP8420A/21A/22A is operated in Mode 1. An access cyc begins when the 68020 places a valid address on the a dress bus and asserts the address strobe (AS). Chip sele (CS) is generated by a 74AS138 decoder. If a refresh Port B access (DP8422A only) is not in progress, the DP8420A/21A/22A will assert the proper RAS dependir on the bank select inputs (B0, B1). After guaranteeing th programmed value of row address hold time, the DP8420A/21A/22A will switch the DRAM address (Q0-9, 10) to the column address and assert CAS. By this tim the 74AS245s have been enabled and the DRAMs place their data on the data bus. The DP8420A/21A/22A al asserts DTACK which is used to generate DSACK0.1 to the 68020.

If a refresh had been in progress, the DP8420A/21A/22A would have delayed the 68020's access by inserting wait states into the access cycle until the refresh was complete and the programmed amount of precharge time was met. This circuit can run up to 16 MHz with one wait state. However, the timing parameters become close to the minimums for the DP8420A/21A/22A parameters. ADS asserted to CLK high (\$400b), CS setup to ADS asserted (\$401) and ADS negated held from CLK (\$405). Problems can also occur if the loading on the clocks generated from the 74AS74 cause too much skew between CLK and CLK. The clock must be inverted to guarantee timing parameters. A solution to this problem is to invert the CLOCK to the 68020 with a 74AS04.

Since the 68020 address strobe can end late in the access, a problem with RAS precharge can occur in back-to-back accesses. In these accesses, the DP8420A/21A/22A will guarantee the precharge time by inserting wait states. To reduce this problem, memory interleaving should be used by tying the low order address bits to the bank selects.

Timing parameters are referenced to the numbers shown in the DP8420A/21A/22A data sheet. Numbered times starting with a "\$" refer to the DP8420A/21A/22A timing parameters. Numbered times starting with "#" refer to the Motorola 68020 data sheet. Equations have been given to allow the user to calculate timing based on his frequency and application. The clock has been chosen at a multiple of 2 MHz only to allow the user to hook the system clock to the PLL delay line clock (DELCLK). If you are running at a frequency that is not a multiple of 2 MHz, it is recommended that you use a clock which is a multiple of 2 MHz for DELCLK. If DELCLK is not a multiple of 2 MHz,  $\overline{ADS}$  to  $\overline{CAS}$ must be recalculated. National Semiconductor Application Note 539 Joe Tate and Rusty Meier



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|             | DESIGN #1 T    | 'IMING AT 16 MHz AND 12 MHz                                       |
|-------------|----------------|-------------------------------------------------------------------|
| the         | Clock Period   | = Tcp16 = 62.5 ns @ 16 MHz                                        |
| ro-         |                | = Tcp12 = 83 ns @ 12 MHz                                          |
| ex-<br>vith | \$400b:        | ADS Asserted Setup to CLK High                                    |
| 2A          |                | = Clock Period - 68020 Clock                                      |
|             |                | to AS Low Max                                                     |
|             |                | = Tcp16 - #9 Max                                                  |
| the         | r              | = 62.5 ns - 30 ns                                                 |
| he          | l              | = 32 ns @ 16 MHz                                                  |
| cle         |                | = Tcp12 - #9 Max                                                  |
| ad-         |                | = 83 ns -40 ns                                                    |
| ect         | ſ              | = 43 ns @ 12 MHz                                                  |
| or          | L              | 40 113 G 12 INTI2                                                 |
| the<br>ing  | \$401:         | CS Setup to ADS Asserted                                          |
| ing<br>the  |                | = 68020 Address to $\overline{AS}$ Maximum                        |
| the         |                | <ul> <li>74AS138 Decoder Maximum</li> </ul>                       |
| -8,         |                | = #11 Max - Tphl Max                                              |
| ne,         |                | = 15 ns - 9 ns                                                    |
| ace         | l              | = 6 ns @ 16 MHz                                                   |
| lso         | L              |                                                                   |
| the         |                | = #11 Max - Tphl Max                                              |
|             |                | = 20  ns - 9  ns                                                  |
| 2A          | l              | = 11 ns @ 12 MHz                                                  |
| vait<br>ete | \$407 & 404:   | Address Valid Setup to ADS Asserted                               |
| net.        | \$107 a 101.   | $= 68020$ Address to $\overline{AS}$ Maximum                      |
| ow-         |                | = #11 Max                                                         |
| ms          | ſ              | = 15 ns @ 16 MHz                                                  |
| to<br>and   | L              |                                                                   |
| 00-         | г              | = #11 Max                                                         |
| 574         | L              | = 20 ns @ 12 MHz                                                  |
| JCK         | \$405:         | ADS Negated Held from CLK High                                    |
| ion<br>h a  |                | = 68020 Minimum Clock to AS                                       |
| la          |                | = #9 Min                                                          |
| SS,         |                | = 3 ns @ 16 MHz                                                   |
| ack         |                | = #9 Min                                                          |
| will        | [              | = 3 ns @ 12 MHz                                                   |
| To<br>by    | # <b>47</b> A. |                                                                   |
| ,           | #47A:          | DSACK0, 1 Setup Time<br>= $\frac{1}{2}$ Clock Period – Max 74AS74 |
| ı in        |                | Delay – Max 74AS32 Delay                                          |
| art-        |                | = 31  ns - 9  ns - 5  ns                                          |
| ım-         | Г              |                                                                   |
| to-         | L              | = 17 ns @ 16 MHz                                                  |
| ow          |                | = 1/2 Tcp12 - TphI Max - TphI Max                                 |
| ind         | -              | = 41  ns - 9  ns - 5  ns                                          |
| of<br>the   |                | = 27 ns @ 12 MHz                                                  |
|             | -              | ······································                            |

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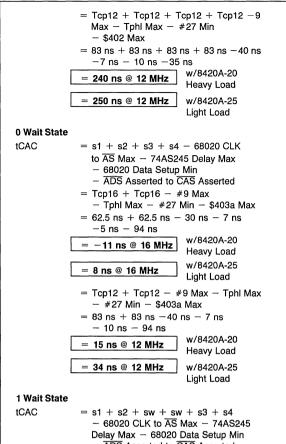
| AN-539 | #47B:           | DSACK0, 1 Hold Time                                                                                                                           | 0 Wait States         | 3                                                                                                                            |
|--------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|------------------------------------------------------------------------------------------------------------------------------|
| AN     |                 | = $\frac{1}{2}$ Clock Period + Min<br>74AS74 Delay + Min 74AS32 Delay<br>= $\frac{1}{2}$ Tcp16 + TphI Min + TphI Min<br>= 31 ns + 5 ns + 1 ns | tRAC                  | = s1 + s2 + s3 + s4 - 68020 CLK to AS<br>Max - 74AS245 Delay Max - 68020<br>Data Setup Min - ADS Asserted to<br>RAS Asserted |
| 1      |                 | = 37 ns @ 16 MHz                                                                                                                              |                       | = Tcp16 + Tcp16 - #9 Max - Tphl                                                                                              |
|        |                 | $= \frac{1}{2}$ Tcp12 + Tphl Min + Tphl Min                                                                                                   |                       | Max — #27 Min — \$402 Max                                                                                                    |
|        |                 | = 41  ns - 9  ns - 5  ns                                                                                                                      |                       | = 62.5 ns + 62.5 ns - 30ns - 7 ns<br>- 5 ns -35 ns                                                                           |
|        |                 | = 47 ns @ 12 MHz                                                                                                                              |                       | = 48 ns @ 16 MHz w/8420A-20                                                                                                  |
|        | RAS Low du      | uring REFRESH                                                                                                                                 |                       | Heavy Load                                                                                                                   |
|        | tRAS            | = Programmed Clocks - [(CLK High to                                                                                                           |                       | = 58 ns @ 16 MHz Light Load                                                                                                  |
|        |                 | Refresh RAS Asserted) – (CLK High to Refresh RAS Negated)]                                                                                    |                       | = Tcp12 + Tcp12 - #9 Max - Tphl<br>Max - #27 Min - \$402 Max                                                                 |
|        |                 | = Tcp16 + Tcp16 - \$55                                                                                                                        |                       | = 83  ns + 83  ns - 40  ns                                                                                                   |
|        |                 | = 62.5  ns + 62.5  ns - 6  ns                                                                                                                 |                       | -7  ns - 10  ns - 35  ns                                                                                                     |
|        |                 | = 119 ns @ 16 MHz                                                                                                                             |                       | = 74 ns @ 12 MHz w/8420A-20<br>Heavy Load                                                                                    |
|        |                 | = Tcp12 + Tcp12 - \$55<br>= 83.3 ns + 83.3 ns - 6 ns                                                                                          | [                     | = 84 ns @ 12 MHz w/8420A-25<br>Light Load                                                                                    |
|        |                 | = 160 ns @ 12 MHz                                                                                                                             | 1 Wait State          | Light Loud                                                                                                                   |
|        |                 |                                                                                                                                               | tRAC                  | = s1 + s2 + sw + sw + s3 + s4                                                                                                |
|        |                 | rge Parameters**                                                                                                                              |                       | - 68020 CLK to AS Max - 74AS245                                                                                              |
|        | \$29b:          | AREQ Negated Setup to CLK High                                                                                                                |                       | Delay Max — 68020 Data Setup Min<br>— ADS Asserted to RAS Asserted                                                           |
|        |                 | = CLOCK Period – CLOCK Low<br>to 68020 AS Negated                                                                                             |                       | = Tcp16 + Tcp16 + Tcp16                                                                                                      |
|        |                 | = Tcp16 - #12                                                                                                                                 | N N                   | – #9 Max – Tphl Max                                                                                                          |
|        |                 | = 62.5 ns - 30 ns                                                                                                                             |                       | — #27 Min — \$402 Max                                                                                                        |
|        |                 | = 32 ns @ 16 MHz                                                                                                                              |                       | = 62.5 ns + 62.5 ns + 62.5 ns − 30 ns<br>− 7 ns − 5 ns −35 ns                                                                |
|        |                 | = Tcp12 - #12<br>= 83 ns - 40 ns                                                                                                              |                       | = 110 ns @ 16 MHz w/8420A-20<br>Heavy Load                                                                                   |
|        |                 | = 43 ns @ 12 MHz                                                                                                                              |                       | = 120 ns @ 16 MHz w/8420A-25<br>Light Load                                                                                   |
|        | tRP             | = s5 + s0 + s1 + s2 - 68020 CLK                                                                                                               |                       | = Tcp12 + Tcp12 + Tcp12 - #9 Max                                                                                             |
|        |                 | Low to AS Negated<br>— [(AREQ to RAS Negated)                                                                                                 |                       | — Tphl Max — #27 Min<br>— \$402 Max                                                                                          |
|        |                 | - (CLK to RAS Asserted)]                                                                                                                      |                       | = 83  ns + 83  ns + 83  ns - 40  ns                                                                                          |
|        |                 | = 2 Tcp16 - #12 - \$50                                                                                                                        |                       | -7  ns - 10  ns - 35  ns                                                                                                     |
|        |                 | = 125  ns - 30  ns - 16  ns                                                                                                                   |                       | = 157 ns @ 12 MHz w/8420A-20                                                                                                 |
|        |                 | = 79 ns @ 16 MHz w/8420A/21A/<br>22A                                                                                                          |                       | Heavy Load                                                                                                                   |
|        |                 | = 81 ns @ 16 MHz w/8420A/21A/<br>22A                                                                                                          |                       | Light Load                                                                                                                   |
|        |                 | = 2 Tcp12 - #12 - \$50                                                                                                                        | 2 Wait States<br>tRAC | s = s1 + s2 + sw + sw + sw + sw + s3                                                                                         |
|        |                 | = 166 ns - 40 ns - 16 ns                                                                                                                      |                       | - s1 + s2 + sw + sw + sw + sw + ss<br>+ s4 - 68020 CLK to $\overline{AS}$ Max                                                |
|        |                 | = 120 ns @ 12 MHz                                                                                                                             |                       | - 74AS245 Delay <u>Max</u> - 68020                                                                                           |
|        | **Note: To gain | n more precharge program 3T.                                                                                                                  |                       | Data Setup Min – ADS Asserted<br>to RAS Asserted                                                                             |
|        |                 | CAC TIMING FOR DRAMS                                                                                                                          |                       | = Tcp16 + Tcp16 + Tcp16 + Tcp16                                                                                              |
|        |                 | pplied for the system shown in <i>Figure 1 (See</i><br>. Since systems and DRAM times vary, the user                                          |                       | — 9 Max — Tphl Max — #27 Min<br>— \$402 Max                                                                                  |
|        |                 | ed to change the following equations to match                                                                                                 |                       | = 62.5  ns + 62.5  ns + 62.5  ns + 62.5  ns                                                                                  |
|        | his system r    | equirements. Timing has been supplied for sys-                                                                                                |                       | -30  ns - 7  ns - 5  ns - 35  ns                                                                                             |
|        |                 | , 1 or 2 wait states. If the DELCLK is not a                                                                                                  |                       | = 173 ps @ 16 MHz w/8420A-20                                                                                                 |
|        |                 | 2 MHz, the timing for tRAH and tASC will in-<br>ause tRAH and tASC will increase, ADS to RAS                                                  |                       | Heavy Load                                                                                                                   |

crease. Because tRAH and tASC will increase, ADS to RAS and ADS to CAS will also increase and must be changed according to the equations given in the data sheet. The ADS to RAS and ADS to CAS will also have to be changed depending on the capacitance of the DRAM array.

w/8420A-25

Light Load

= 183 ns @ 16 MHz



- ADS Asserted to CAS Asserted
   Tcp16 + Tcp16 + Tcp16 #9 Max
   TphI Max #27 Min \$403a Max
   62.5 ns + 62.5 ns + 62.5 ns 30 ns
  - 7 ns 5 ns 94 ns

w/8420A-20 = 51 ns @ 16 MHz Heavy Load w/8420A-25 = 70.5 ns @ 16 MHz Light Load = Tcp12 + Tcp12 + Tcp12 - #9 Max - Tphl Max - #27 Min - \$403a Max = 83 ns + 83 ns + 83 ns - 40 ns - 7 ns - 10 ns - 94 ns w/8420A-20 = 98 ns @ 12 MHz Heavy Load w/8420A-25 = 134 ns @ 12 MHz Light Load 2 Wait States tCAC = s1 + s2 + sw + sw + sw + sw + s3+ s4 - 68020 CLK to AS Max - 74AS245 Delay Max - 68020 Data Setup Min - ADS Asserted to CAS Asserted = Tcp16 + Tcp16 + Tcp16 + Tcp16 – #9 Max – Tphl Max – #27 Min - \$403a Max = 62.5 ns + 62.5 ns + 62.5 ns +62.5 ns - 30 ns - 7 ns - 5 ns - 94 ns w/8420A-20 = 114 ns @ 16 MHz Heavy Load w/8420A-25 = 133 ns @ 16 MHz Light Load = Tcp12 + Tcp12 + Tcp12 + Tcp12 — #9 Max — TphI Max — #27 Min - \$403a Max = 83 ns + 83 ns + 83 ns + 83 ns - 40 ns - 7 ns - 10 ns - 74 ns w/8420A-20 = 181 ns @ 12 MHz Heavy Load w/8420A-25 = 200 ns @ 12 MHz Light Load

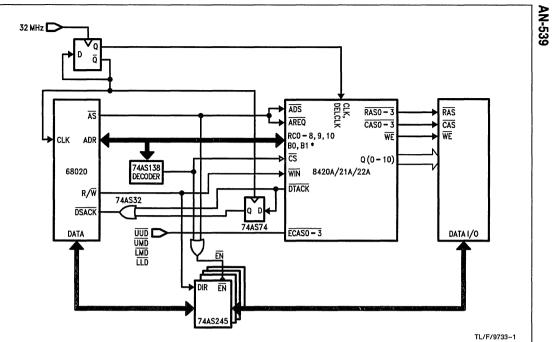
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|            | Design # 1 Programming Bits                                         |                               |
|------------|---------------------------------------------------------------------|-------------------------------|
| Bits       | Description                                                         | Value                         |
| R0, R1     | $\overline{RAS}$ Low during REFRESH = 2T<br>RAS Precharge Time = 2T | R0 = 0<br>R1 = 1              |
| R2, R3     | DTACK Generation Modes for Non-Burst Accesses ( $1/_2$ T after RAS) | R2 = 0<br>R3 = 1              |
| R4, R5     | DTACK during Burst Mode                                             | R4 = x<br>R5 = x              |
| R6         | Add Wait States with WAITIN                                         | R6 = x                        |
| R7         | DTACK Mode Selected                                                 | R7 = 1                        |
| R8         | Non-Interleaved Mode                                                | R8 = 1                        |
| R9         | Staggered or All REFRESH                                            | R9 = u                        |
| C0, C1, C2 | Divisor for DELCLK                                                  | C0 = s<br>C1 = s<br>C2 = s    |
| C3         | + 30 REFRESH                                                        | C3 = 0                        |
| C4, C5, C6 | RAS, CAS Configuration Mode<br>*Choose An All CAS Mode              | C4 = u $C5 = u$ $C6 = u$      |
| C7         | Select 0 ns Column Address Setup                                    | C7 = 1                        |
| C8         | Select 15 ns Row Address Hold                                       | C8 = 1                        |
| C9         | CAS is Delayed to Next Rising<br>CLOCK during Writes                | C9 = 1                        |
| В0         | The Row/Column Bank Latches<br>Are in Fall Through Mode             | B0 = 1                        |
| B1         | Access Mode 1                                                       | B1 = 1                        |
| ECAS0      | CAS not extended beyond RAS                                         | $\overline{\text{ECAS}}0 = 0$ |

x = don't care u = user defined

u = user defined s = system dependent

| s @ 16 MHz | s @ 12 MHz |
|------------|------------|
| C0 = 0     | C0 = 0     |
| C1 = 1     | C1 = 0     |
| C2 = 0     | C2 = 1     |



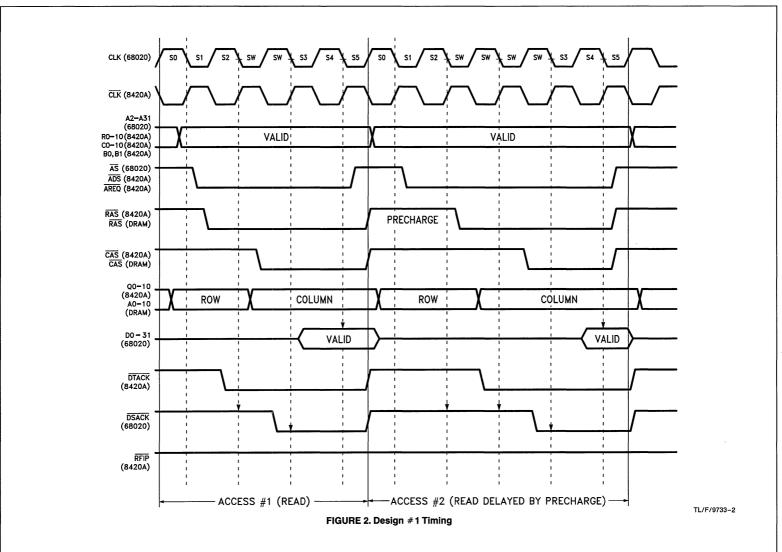
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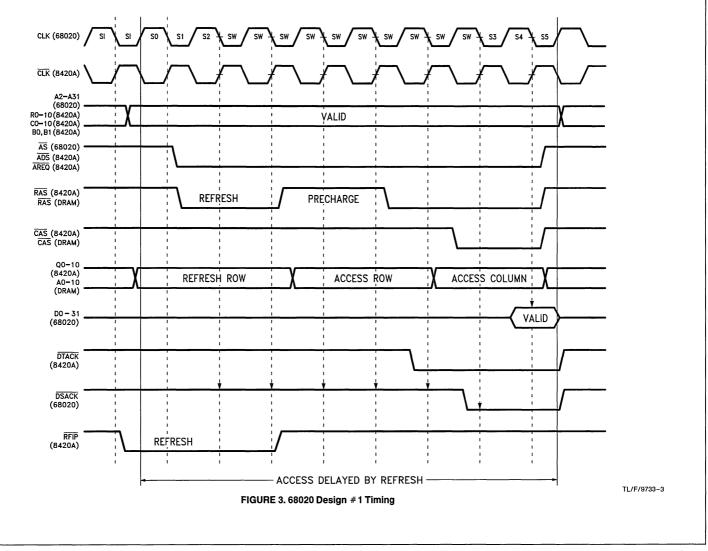
\*Tie least significant ADR bits (A2, A3) to B0, B1.

FIGURE 1. Design # 1, 68020 up to 16 MHz with 1 Wait State

4



4-66





683-NA

#### **DESIGN #2 DESCRIPTION**

Design #2 is a modification of design #1. This design allows a DRAM array up to 64 Mbytes. However, driving an array with greater capacitance than specified in the data sheet requires derating the  $\overline{\text{ADS}}$  to  $\overline{\text{RAS}}$  and  $\overline{\text{ADS}}$  to  $\overline{\text{CAS}}$  times. Smaller DRAM arrays can derate times by interpolating times in the DP8420A/21A/22A data sheet timing parameters.

This design differs from design #1 in that a latch was added to produce ADS and AREQ. This latch asserts ADS and AREQ at the beginning of the 68020 "S2" clock. This latch was added to increase the time from ADS asserted to CLK (\$400b), CS setup to ADS asserted (\$401) and ADS negated held from CLK high (\$405). The DP8420/21/22 is operated in Mode 1. An access cycle begins when the 68020 places a valid address on the address bus and asserts ADS. If the address is in the address space of the DRAM, the 74AS138 decoder asserts CS. During the next positive clock level, the latch is set which produces ADS and AREQ. If a refresh or Port B access is not in progress, the DP8420A/21A/22A will assert the proper RAS depending on programming and the bank select inputs (B0, B1). After guaranteeing the programmed value of row address hold time, the DP8420A/21A/22A will switch the DRAM address (Q0-8, 9, 10) to the column address and assert CAS. By this time the 74AS245s have been enabled and the DRAMs place their data on the data bus. The DP8420A/21A/22A also asserts DTACK which is used to generate DSACK0,1 to the 68020. When the 68020 negates AS, the latch is cleared and the access is terminated.

If a refresh or Port B access had been in progress, the DP8420A/21A/22A would have delayed the 68020 access by inserting wait states into the access cycle until the refresh was complete and the programmed amount of precharge was met. This circuit can run up to 20 MHz with 2 wait states. It is suggested that the least significant address bits be tied to the bank select inputs (B0, B1). This will reduce the charce of having to insert wait states to guarantee RAS precharge time. To keep the delays as specified in the data sheet, it is recommended that DELCLK is a multiple of 2 MHz.

#### DESIGN #2 TIMING AT 20 MHz AND 16.667 MHz

| Clock Period | = Tcp20 = 50 ns @ 20 MHz<br>= Tcp16 = 60 ns @ 16.667 MHz                                                                                                                      |  |  |
|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| \$400b:      | ADS Asserted to CLK High<br>= Clock Period - 74AS04 Maxhl<br>- 74AS02 Maxhh - 74AS02 Maxhl<br>= Tcp20 - Tphl Max - Tphh Max<br>- Tphl Max<br>= 50 ns - 4 ns - 4.5 ns - 4.5 ns |  |  |
|              | = 37 ns @ 20 MHz                                                                                                                                                              |  |  |
|              | = Tcp16 - Tphl Max - Tphl Max<br>- Tphl Max<br>= 60 ns - 4 ns - 4.5 ns - 4.5 ns                                                                                               |  |  |
|              | = 47 ns @ 16.667 MHz                                                                                                                                                          |  |  |
|              |                                                                                                                                                                               |  |  |

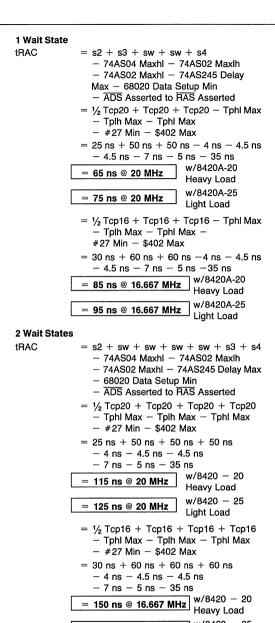
| \$401:         | CS Setup to ADS Asserted<br>= Clock Period + 74AS04 Minhl<br>+ 74AS02 Minlh + 74AS02 Minhl<br>68020 Clock to Address Max<br>- 74AS138 Decoder Maxhl<br>= Tcp20 + Tphl Min + Tph Min<br>+ Tphl Min - #6 Max - Tphl Max<br>= 50 ns + 1 ns + 1 ns + 1 ns<br>- 25 ns - 9 ns<br>= 19 ns @ 20 MHz<br>= Tcp16 + Tphl Min + Tplh Min |
|----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                | + Tphi Min - #6 Max - Tphi Max<br>= $60 \text{ ns} + 1 \text{ ns} + 1 \text{ ns} - 30 \text{ ns} - 9 \text{ ns}$                                                                                                                                                                                                             |
|                | = 24 ns @ 16.667 MHz                                                                                                                                                                                                                                                                                                         |
| \$404 & \$407: | Address Setup to ADS Asserted<br>= Clock Period + 74AS04 Minhl<br>+ 74AS02 Minlh + 74AS02 Minhl<br>68020 Clock to Address Max<br>= Tcp20 + Tphl Min + Tphl Min<br>+ Tphl Min - #6 Max<br>= 50 ns + 1 ns + 1 ns + 1 ns - 25 ns                                                                                                |
|                | = 28 ns @ 20 MHz                                                                                                                                                                                                                                                                                                             |
|                | = Tcp16 + Tphl Min + Tplh Min<br>+ Tphl Min - #6 Max                                                                                                                                                                                                                                                                         |
|                | = 60  ns + 1  ns + 1  ns + 1  ns - 30  ns                                                                                                                                                                                                                                                                                    |
|                | = 33 ns @ 16.667 MHz                                                                                                                                                                                                                                                                                                         |
| \$405:         | ADS Negated Held from CLK High<br>= 74AS04 Minhl + 74AS02 Minlh<br>+ 74AS02 Minhl<br>= Tphl Min + Tplh Min + Tphl Min                                                                                                                                                                                                        |
|                | = 1  ns + 1  ns + 1  ns                                                                                                                                                                                                                                                                                                      |
|                | = 3 ns @ 20 MHz                                                                                                                                                                                                                                                                                                              |
|                | = TphI Min + Tplh Min + TphI Min<br>= 1 ns + 1 ns + 1 ns                                                                                                                                                                                                                                                                     |
|                | = 3 ns @ 16.667 MHz                                                                                                                                                                                                                                                                                                          |
| #47A:          | DSACK0,1 Setup Time                                                                                                                                                                                                                                                                                                          |
|                | <ul> <li>= 1/2 Clock Period - Max 74AS74</li> <li>Delay - Max 74AS32 Delay 1/2 Tcp20</li> <li>- Tphl Max - Tphl Max</li> <li>= 25 ns - 9 ns - 5 ns</li> </ul>                                                                                                                                                                |
|                | = 11 ns @ 20 MHz                                                                                                                                                                                                                                                                                                             |
|                | $= \frac{1}{2}$ Tcp16 - Tphi Max - Tphi Max<br>= 30 ns - 9 ns - 5 ns                                                                                                                                                                                                                                                         |
|                | = 16 ns @ 16.667 MHz                                                                                                                                                                                                                                                                                                         |
| #47B:          | $\overrightarrow{DSACK0,1} \text{ Hold Time}$ $= \frac{1}{2} \text{ Clock Period + Min 74AS74 Delay}$ $+ \text{ Min 74AS32 Delay}$ $= \frac{1}{2} \text{ Tcp20 + Tphl Min + Tphl Min}$ $= 25 \text{ ns} + 5 \text{ ns} + 1 \text{ ns}$ $= 31 \text{ ns} @ 20 \text{ MHz}$                                                    |
|                | = 30  ns - 5  ns - 1  ns                                                                                                                                                                                                                                                                                                     |
|                | = 36 ns @ 16.667 MHz                                                                                                                                                                                                                                                                                                         |

| RAS Low du        | ring REFRESH                                                                                                                                                                                                                                                                                        |
|-------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| tRAS              | <ul> <li>Programmed Clocks</li> <li>- [(CLK High to Refresh RAS Asserted)</li> <li>- (CLK High to Refresh RAS Negated)]</li> <li>= Tcp20 + Tcp20 + Tcp20</li> <li>+ Tcp20 - \$55</li> <li>= 200 ns -6 ns</li> </ul>                                                                                 |
|                   | = 194 ns @ 20 MHz                                                                                                                                                                                                                                                                                   |
|                   | = Tcp16 + Tcp16 - \$55<br>= 120 ns - 6 ns                                                                                                                                                                                                                                                           |
|                   | = 114 ns @ 16.667 MHz                                                                                                                                                                                                                                                                               |
| <b>RAS</b> Precha | rge Parameters                                                                                                                                                                                                                                                                                      |
| \$29b:            | AREQ Negated Setup to CLK High         = CLOCK Period – Max 74AS04 – Max 74AS02         74AS02 – Max 74AS02 – Max 74AS02                                                                                                                                                                            |
|                   | = 50  ns - 5  ns - 4.5  ns - 4.5  ns                                                                                                                                                                                                                                                                |
|                   | = 31.5 ns @ 20 MHz                                                                                                                                                                                                                                                                                  |
|                   | =60 ns - 5 ns - 4.5 ns - 4.5 ns - 4.5 ns                                                                                                                                                                                                                                                            |
|                   | = 41.5 ns @ 16.667 MHz                                                                                                                                                                                                                                                                              |
| tRP               | <ul> <li>Programmed Clocks - Max 74AS04         <ul> <li>Max 74AS02 - Max 74AS02</li> <li>Max 74AS02 [(AREC to FAS Negated) - (CLK to FAS Asserted)]</li> </ul> </li> <li>3 Tcp20 - TphI - TphI - TphI         <ul> <li>TplA - \$50</li> </ul> </li> <li>150 ns - 4 ns - 4.5 ns - 4.5 ns</li> </ul> |
|                   | — 16 ns                                                                                                                                                                                                                                                                                             |
|                   | = 116.5 ns @ 20 MHz                                                                                                                                                                                                                                                                                 |
|                   | = 2 Tcp16 – Tphl – Tplh – Tphl<br>– Tplh – \$50                                                                                                                                                                                                                                                     |
|                   | = 120 ns - 4 ns - 4.5 ns - 4.5 ns<br>- 4.5 ns - \$50                                                                                                                                                                                                                                                |
|                   | = 86.5 ns @ 16.667 MHz                                                                                                                                                                                                                                                                              |
| *To gain more p   | recharge @ 16.667 MHz program 3T precharge.                                                                                                                                                                                                                                                         |

#### \*To gain more precharge @ 16.667 MHz program 3T precharge.

#### tRAC AND tCAC TIMING FOR DRAMs

Timing is supplied for the system shown in *Figure 4 (See Figures 5, 6)*. Since systems and DRAM times vary, the user is encouraged to change the following equations to match his system requirements. Timing has been supplied for systems with 1, 2 or 3 wait states. If the DELCLK is not a multiple of 2 MHz, the timing for tRAH and tASC will change. Because tRAH and tASC will change,  $\overline{\text{ADS}}$  to  $\overline{\text{RAS}}$  and  $\overline{\text{ADS}}$  to  $\overline{\text{CAS}}$  will also vary and must be changed according to the equations given in the data sheet. The  $\overline{\text{ADS}}$  to  $\overline{\text{RAS}}$  and  $\overline{\text{ADS}}$  to  $\overline{\text{CAS}}$  will also have to be changed depending on the capacitance of the DRAM array.



AN-539

= 160 ns @ 16.667 MHz w/8420 - 25 Light Load

#### **AN-539** 3 Wait States 2 Wait States tRAC = s2 + sw + sw + sw + sw + sw tCAC = s2 + sw + sw + sw + sw + s3 + s4+ s3 + s4 + sw - 74AS04 Maxhl + 74AS04 Maxhl - 74AS04 Maxlh - 74AS02 Max - 74AS02 Maxhl - 74AS02 Maxhl - 74AS245 Delay Max - 68020 Data Setup Min - 74AS245 Max Delay - 68020 Data Setup Min - ADS - ADS Asserted to CAS Asserted Asserted to RAS Asserted $= \frac{1}{2} Tcp 20 + Tcp 20 + Tcp 20 + Tcp 20$ $= \frac{1}{2} Tcp 20 + Tcp 20 + Tcp 20 + Tcp 20$ - Tphi Max – Tpih Max – Tphi Max + Tcp20 - Tphl Max - Tplh Max - #27 Min - \$403a Max - Tphl Max - #27 Min - \$402 Max = 25 ns + 50 ns + 50 ns + 50 ns - 4 ns - 4.5 ns - 4.5 ns = 25 ns + 50 ns + 50 ns + 50 ns - 50 ns - 4 ns - 4.5 ns - 4.5 ns - 7 ns - 5 ns - 94 ns - 7 ns - 5 ns - 35 ns w/8420 - 20 = 56 ns @ 20 MHz w/8420 - 20 Heavy Load = 165 ns @ 20 MHz Heavy Load w/8420 - 25 = 85 ns @ 20 MHz w/8420 - 25 Light Load = 175 ns @ 20 MHz Light Load $= \frac{1}{2}$ Tcp16 + Tcp16 + Tcp16 + Tcp16 $= \frac{1}{2}$ Tcp16 + Tcp16 + Tcp16 + Tcp16 - Tphi Max - Tpih Max - Tphi Max - #27 Min - \$403a Max + Tcp16 - TphI Max - Tplh Max - Tphi Max - #27 Min - \$402 Max = 30 ns + 60 ns + 60 ns + 60 ns= 30 ns + 60 ns + 60 ns + 60 ns - 60 ns- 4 ns - 4.5 ns - 4.5 ns - 4 ns - 4.5 ns - 4.5 ns — 7 ns — 5 ns — 94 ns - 7 ns - 5 ns - 35 ns w/8420 - 20 = 91 ns @ 16.667 MHz = 210 ns @ 16.667 MHz w/8420 - 20 Heavy Load w/8420 - 25 = 120 ns @ 16.667 MHz | Light Load w/8420 - 25 = 220 ns @ 16.667 MHz Light Load **3 Wait States** 1 Wait State tCAC = s2 + sw + sw + sw + sw + sw + s3 + s4 + sw - 74AS04 Maxhl tCAC = s2 + s3 + sw + sw + s4 - 74AS04 Maxhl - 74AS04 Maxlh - 74AS02 Max - 74AS02 Maxhl - 74AS02 Maxhl - 74AS245 Delay - 74AS245 Max Delay - 68020 Max - 68020 Data Setup Min Data Setup Min - ADS - ADS Asserted to CAS Asserted Asserted to CAS Asserted $= \frac{1}{2}$ Tcp20 + Tcp20 + Tcp20 - TphI Max $= \frac{1}{2}$ Tcp20 + Tcp20 + Tcp20 + Tcp20 - Tplh Max - TphI Max + Tcp20 - Tphi Max - Tpih Max - #27 Min - \$403a Max - TphI Max - #27 Min - \$403a Max = 25 ns + 50 ns + 50 ns - 4 ns - 4.5 ns = 25 ns + 50 ns + 50 ns + 50 ns- 4.5 ns - 7 ns - 5 ns - 94 ns - 50 ns - 4 ns - 4.5 ns - 4.5 ns w/8420 - 20 — 7 ns — 5 ns — 94 ns = 6 ns @ 20 MHz Heavy Load w/8420 - 20 = 106 ns @ 20 MHz Heavy Load w/8420 - 25 = 35 ns @ 20 MHz Light Load w/8420 - 25 = 135 ns @ 20 MHz Light Load = 1/2 Tcp16 + Tcp16 + Tcp16 - TphI Max - Tplh Max - Tphl Max - $= \frac{1}{2}$ Tcp16 + Tcp16 + Tcp16 + Tcp16 #27 Min - \$403a Max + Tcp16 - Tphi Max - Tpih Max - TphI Max - #27 Min - \$403a Max = 30 ns + 60 ns + 60 ns - 4 ns - 4.5 ns - 4.5 ns - 7 ns - 5 ns - 94 ns = 30 ns + 60 ns + 60 ns + 60 ns - 60 nsw/8420 - 20 - 4 ns - 4.5 ns - 4.5 ns = 26 ns @ 16.667 MHz - 7 ns - 5 ns - 94 ns Heavy Load w/8420 - 20 w/8420 - 25 = 151 ns @ 16.667 MHz = 55 ns @ 16.667 MHz Light Load Heavy Load w/8420 - 25

4-70

= 180 ns @ 16.667 MHz Light Load

| Bits       | Description                                               | Value                      |
|------------|-----------------------------------------------------------|----------------------------|
| R0, R1     | RAS Low during REFRESH<br>RAS Precharge Time              | R0 = s<br>R1 = s           |
| R2, R3     | DTACK Generation Modes<br>for Non-Burst (1T after RAS)    | R2 = 1<br>R3 = 0           |
| R4, R5     | DTACK during Burst Mode                                   | R4 = x $R5 = x$            |
| R6         | Add Wait States with WAITIN                               | R6 = 0                     |
| R7         | DTACK Mode Selected                                       | R7 = 1                     |
| R8         | Non-Interleaved Mode                                      | R8 = 1                     |
| R9         | Staggered or All REFRESH                                  | R9 = u                     |
| C0, C1, C2 | Divisor for DELCLK                                        | C0 = s<br>C1 = s<br>C2 = s |
| C3         | + 30 Fine Tune                                            | C3 = s                     |
| C4, C5, C6 | RAS, CAS Configuration Mode *Choose an All CAS Mode       | C4 = u $C5 = u$ $C6 = u$   |
| C7         | Select 0 ns Column Address Setup C7 =                     |                            |
| C8         | Select 15 ns Row Address Hold C8 = 1                      |                            |
| C9         | CAS is Delayed to Next Rising<br>CLOCK Edge during Writes |                            |
| В0         | The Row/Column Bank Latches are in Fall Through Mode      | B0 = 1                     |
| B1         | Access Mode 1                                             | B1 = 1                     |
| ECAS0      | CAS not extended beyond RAS ECAS0 = 0                     |                            |

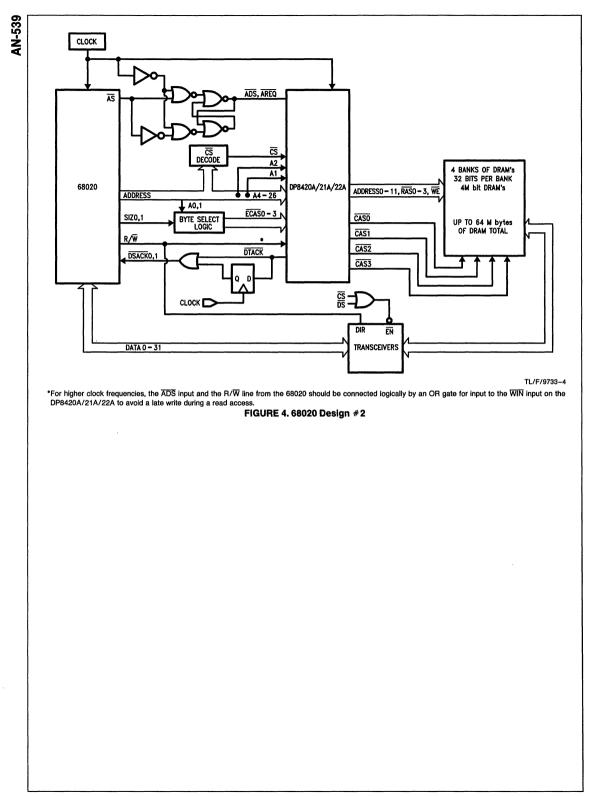
 $\mathbf{x} = \mathbf{don't} \mathbf{care}$ 

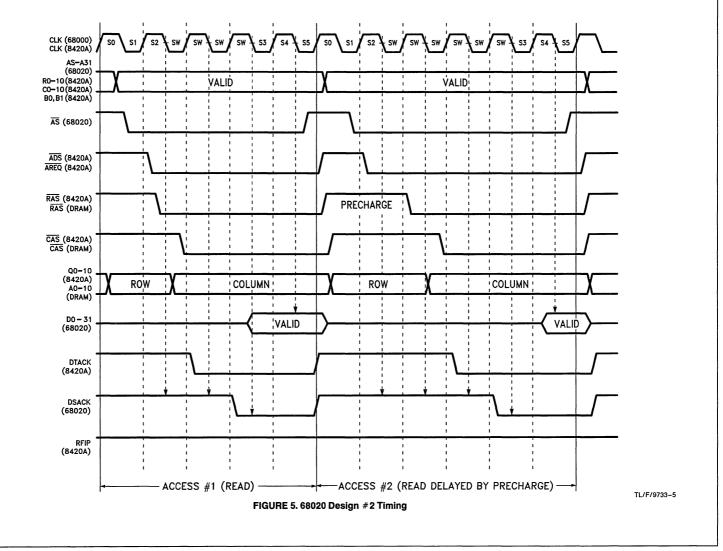
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 $\mathsf{u} = \mathsf{user} \mathsf{ defined}$ 

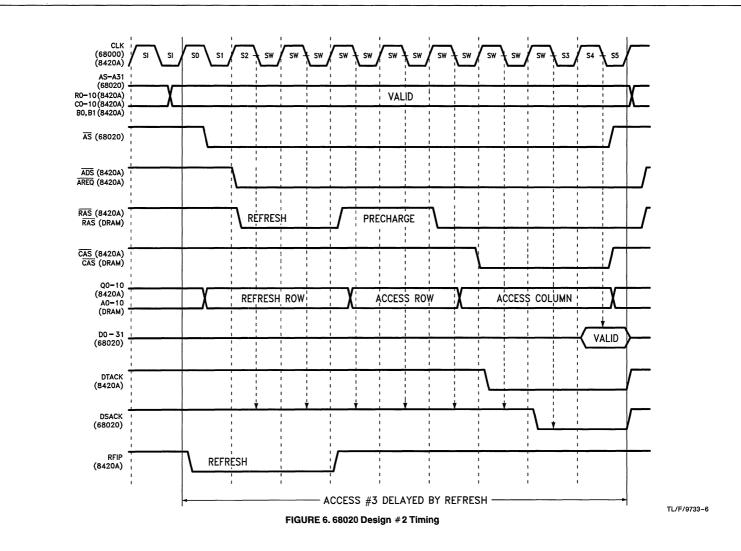
s = system dependent

| s @ 16.667 MHz |        | s @ 2  | 0 MHz  |
|----------------|--------|--------|--------|
| R0 = 0         | C0 = 0 | R0 = 1 | C0 = 0 |
| R1 = 1         | C1 = 1 | R1 = 1 | C1 = 0 |
|                | C2 = 0 | 1      | C2 = 0 |
|                | C3 = 0 |        | C3 = 0 |





4-73



#### **DESIGN #3 DESCRIPTION**

Design #3 uses two 68020s sharing a common DRAM array. Port A's interface is the same as design #1.

The two processors share the same CLK. By using the same CLK, the request from Port B do not have to be synchronized to the system CLK.

In this design, an access begins from Port A when the 68020 asserts  $\overline{AS}$ . Assuming the DP8422 has granted access to Port A through GRANTB negated,  $\overline{AS}$  will assert RAS. After guaranteeing the programmed value of tRAH, the DP8422 will switch the Q outputs to the column address tASC before asserting  $\overline{CAS}$ . By this time the 74AS245s have been enabled and the DRAM places its data on the data bus. The cycle is terminated by the DP8422 asserting  $\overline{DTACK}$ . The 68020 will then sample the data from the data bus and negated  $\overline{AREQ}$ .  $\overline{AREQ}$  negated will cause  $\overline{RAS}$  to be negated.

If at any time during Port A's access Port B had requested an access by asserting  $\overline{AREQB}$ , Port B's 68020 would have been delayed by keeping  $\overline{ATACKB}$  negated. This would have inserted wait states into Port B's access. After Port A's access terminates, GRANTB is asserted to allow Port B's address through the mux. On the next rising CLOCK edge,  $\overline{RAS}$  will be asserted. Again, after guaranteeing the necessary address parameters,  $\overline{CAS}$  will be asserted.

Refresh will happen after the current access is completed and precharge time has been met. During this refresh, all accesses will be held off.

Since back-to-back accesses can cause precharge delays, it is recommended that the low order address bits be tied to the bank select inputs.

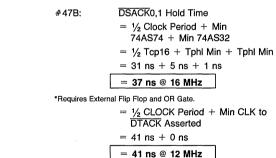
#### **DESIGN #3 TIMING DESCRIPTION** Clock Period = Tcp16 = 65 ns @ 16 MHz = Tcp12 = 83 ns @ 12 MHz Port A Timing \$400b: ADS Asserted Setup to CLK High = Clock Period - 68020 Clock to AS Low Max = Tcp16 - #9 Max = 62.5 ns - 30 ns = 32.5 ns @ 16 MHz = Tcp12 - #9 Max = 83 ns - 40 ns = 43 ns @ 12 MHz CS Setup to ADS Asserted \$401: = 68020 AS Address to AS Max + 74AS244 Min - 74AS138 Decoder Max = #11 Max + TphI Min + TphI Max = 15 ns + 2 ns - 9 ns = 8 ns @ 16 MHz = #11 Max + TphI Min + TphI Max = 20 ns + 2 ns - 9 ns = 13 ns @ 12 MHz

|            | \$404 & 407:      | Address Valid Setup to ADS Asserted                               |
|------------|-------------------|-------------------------------------------------------------------|
| r-         |                   | = 68020 Address to $\overline{AS}$ + Min 74AS244<br>- Max 74AS244 |
| е          |                   | = #11 Max + TphI Min + TphI Max                                   |
| 1-         |                   | = 15 ns + 2 ns - 6 ns                                             |
|            | [                 | = 11 ns @ 16 MHz                                                  |
| е          | L                 |                                                                   |
| <b>)-</b>  |                   | = #11 Max + TphI Min - TphI Max                                   |
| rt         |                   | = 20  ns + 2  ns - 6  ns                                          |
| H,<br>is   | [                 | = 16 ns @ 12 MHz                                                  |
| s          | \$405:            | ADS Negated Held from CLK                                         |
| е          |                   | = 68020 Min CLOCK to $\overline{AS}$                              |
| g          |                   | = #9 Min                                                          |
| а          |                   |                                                                   |
| е          |                   | = 3 ns                                                            |
|            |                   | = 3 ns @ 16 MHz                                                   |
| d<br>e     |                   | = #9 Min + Tphl Min                                               |
| d          |                   | = 3 ns + 2 ns                                                     |
| s          | ]                 |                                                                   |
| s          | Ľ                 | = 3 ns @ 12 MHz                                                   |
| э,         | #47A:             | DSACK0,1 Setup Time                                               |
| 8-         |                   | = 1/2 CLOCK Period - 74AS74 Delay Max                             |
|            |                   | - 74AS32 Delay Max                                                |
| d          |                   | = 1/2 Tcp16 - TphI Max - TphI Max                                 |
| d <b>i</b> |                   | = 31  ns - 9  ns - 5  ns                                          |
|            | [                 | = 18 ns @ 16 MHz                                                  |
| s,<br>o    | * Doguizoo Eutore |                                                                   |
| 0          | riequires extern  | al Flip-Flop and OR Gate.                                         |
|            |                   | $= \frac{1}{2}$ CLOCK Period – CLK                                |
|            |                   | to DTACK Asserted                                                 |

. . . . . . . . . .

- to DTACK Asserted
- = 1/2 Tcp \$18 Max
- = 41 ns 33 ns
- = 8 ns @ 12 MHz

\*Program as DTACK of 11/2 No External Flip-Flop Required.



\*Program as DTACK of 11/2.

| #450 & \$454: | Address Setup to CLK High                                                                                                                                                     |        | = #11 - Tphl Max + Tphl Min + Tphl M                                                               |
|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|----------------------------------------------------------------------------------------------------|
|               | = CLOCK Period - CLK High to GRANTB                                                                                                                                           |        | = 20 ns - 6 ns + 2 ns + 2 ns                                                                       |
|               | Negated - 74AS04 Delay Max                                                                                                                                                    |        |                                                                                                    |
|               | - 74AS00 Delay Max                                                                                                                                                            |        | = 18 ns @ 12 MHz                                                                                   |
|               | - 74AS00 Delay Max                                                                                                                                                            | \$117: | AREQ Negated Pulse Width                                                                           |
|               | — 74AS244 Delay                                                                                                                                                               | φ117.  | = AS Negated Width                                                                                 |
|               | = Tcp16 - \$109 Max - Tplh - Tphl                                                                                                                                             |        | = #15 Min                                                                                          |
|               | — Tphl — Tzh                                                                                                                                                                  |        |                                                                                                    |
|               | = 62.5 ns - 26 ns - 5 ns - 4.5 ns                                                                                                                                             |        | = 40 ns @ 16 MHz                                                                                   |
| _             | - 4.5 ns - 9 ns                                                                                                                                                               |        | = #15 Min                                                                                          |
|               | = 13.5 ns @ 16 MHz                                                                                                                                                            |        | = 50 ns @ 12 MHz                                                                                   |
|               | = tcp12 - \$109 Max - Tplh - Tphl                                                                                                                                             | " 47 - | DOACKO & Catura Time                                                                               |
|               | – Tphl – Tzh                                                                                                                                                                  | #47a   | DSACK0,1 Setup Time                                                                                |
|               | = 83 ns - 32 ns - 5 ns - 4.5 ns                                                                                                                                               |        | $= \frac{1}{2} \text{ CLOCK Period} - \text{Max 74AS74}$                                           |
|               | – 4.5 ns – 9 ns                                                                                                                                                               |        | - Max 74AS32                                                                                       |
| Г             | = 34 ns @ 12 MHz                                                                                                                                                              |        | $= \frac{1}{2}$ Tcp16 + Min Tphl + Min Tphl                                                        |
| L             |                                                                                                                                                                               |        | = 31 ns - 9 ns - 5 ns                                                                              |
| Port B Timing |                                                                                                                                                                               |        | = 17 ns @ 16 MHz                                                                                   |
| \$100:        | AREQB Held Negated from CLK High                                                                                                                                              |        | = 1/2 Tcp12 - TphI Max - TphI Max                                                                  |
|               | = CLK to AS Min + 74AS32 Min                                                                                                                                                  |        | = 41 ns - 9 ns - 5 ns                                                                              |
|               | = #9 Min + Tphl Min                                                                                                                                                           |        | = 27 ns @ 12 MHz                                                                                   |
|               | = 3 ns + 2 ns                                                                                                                                                                 |        | - 27 113 @ 12 MI12                                                                                 |
| Г             |                                                                                                                                                                               | #47B   | DSACK0,1 Hold Time                                                                                 |
| L             | = 5 ns @ 16 MHz                                                                                                                                                               |        | = $\frac{1}{2}$ CLOCK Period + Min 74AS74                                                          |
|               | = #9 Min + Tphl Min                                                                                                                                                           |        | + Min 74AS32                                                                                       |
|               | = 3  ns + 2  ns                                                                                                                                                               |        | = ½ Tcp16 + Min TphI + Min TphI                                                                    |
| Γ             | = 5 ns @ 12 MHz                                                                                                                                                               |        | = 31  ns + 5  ns + 1  ns                                                                           |
|               |                                                                                                                                                                               |        | = 37 ns @ 16 MHz                                                                                   |
| \$101:        | AREQB Asserted Setup to CLK High                                                                                                                                              |        |                                                                                                    |
|               | = Clock Period – CLK to AS Max                                                                                                                                                |        | $= \frac{1}{2}$ Tcp12 + Min TphI + Min TphI                                                        |
|               | - 74AS32 Max                                                                                                                                                                  |        | = 41  ns + 5  ns + 1  ns                                                                           |
|               | = Tcp16 - #9 Max - TphI Max                                                                                                                                                   |        | = 47 ns @ 12 MHz                                                                                   |
|               | = 62.5 ns - 30 ns - 6 ns                                                                                                                                                      |        |                                                                                                    |
| Г             | = 26.5 ns @ 16 MHz                                                                                                                                                            | PASIOW | during REFRESH                                                                                     |
|               |                                                                                                                                                                               |        |                                                                                                    |
|               | = Tcp12 - #9 Max - Tphi Max                                                                                                                                                   | tRAS   | <ul> <li>Programmed CLOCKs</li> <li>         — [(CLK High to Refresh RAS Asserte)     </li> </ul>  |
| _             | = 83  ns - 40  ns - 6  ns                                                                                                                                                     |        | <ul> <li>– (CLK High to Refresh RAS Negated</li> <li>– (CLK High to Refresh RAS Negated</li> </ul> |
|               | = 37 ns @ 12 MHz                                                                                                                                                              |        | = Tcp16 + Tcp16 - \$55                                                                             |
| -             |                                                                                                                                                                               |        | = 62.5  ns + 62.5  ns - 6  ns                                                                      |
| \$110:        | Row Address Setup to CLK High                                                                                                                                                 |        |                                                                                                    |
|               | = CLOCK Period – CLK High to GRANTB                                                                                                                                           |        | = 119 ns @ 16 MHz                                                                                  |
|               | Asserted - 74AS04 Delay Max                                                                                                                                                   |        | = Tcp12 + Tcp12 - \$55                                                                             |
|               | - 74AS00 Delay Max - 74AS244 Delay                                                                                                                                            |        | = 83.3 ns +83.3 ns - 6 ns                                                                          |
|               | = Tcp16 - \$108 - Tplh - Tphl - Tzh                                                                                                                                           |        | = 160 ns @ 12 MHz                                                                                  |
| r             | = 60 ns - 30 ns - 5 ns - 4.5 ns - 9 ns                                                                                                                                        |        |                                                                                                    |
| L             | = 11.5 ns @ 16 MHz                                                                                                                                                            |        | harge Parameters                                                                                   |
|               | = Tcp12 - \$108 - Tplh - Tphl - Tzh                                                                                                                                           | \$29b: | AREQ Negated Setup to CLK High                                                                     |
|               | = 80 ns - 30 ns - 5 ns - 4.5 ns - 9 ns                                                                                                                                        |        | = CLOCK Period                                                                                     |
| Г             | = 31.5 ns @ 20 MHz                                                                                                                                                            |        | <ul> <li>CLOCK Low to AS Negated</li> </ul>                                                        |
|               |                                                                                                                                                                               |        | = 62.5 ns - 30 ns                                                                                  |
| _             | Address Valid Setup to AREQB Asserted                                                                                                                                         |        | = 32 ns @ 16 MHz                                                                                   |
| \$114:        |                                                                                                                                                                               |        |                                                                                                    |
| \$114:        | = Min Address to $\overline{AS}$ - 74AS244 Max                                                                                                                                |        |                                                                                                    |
| \$114:        | <u> </u>                                                                                                                                                                      |        | = Tcp12 - #12<br>= 83 ns - 40 ns                                                                   |
| \$114:        | = Min Address to $\overline{AS}$ - 74AS244 Max                                                                                                                                |        | = 83 ns - 40 ns                                                                                    |
| \$114:        | <ul> <li>Min Address to AS - 74AS244 Max</li> <li>+ 74AS244 Min + 74AS32 Min</li> </ul>                                                                                       |        | -                                                                                                  |
| \$114:<br>Г   | <ul> <li>Min Address to AS - 74AS244 Max</li> <li>+ 74AS244 Min + 74AS32 Min</li> <li>= #11 - TphI Max + TphI Min + TphI Min</li> <li>= 15 ns - 6 ns + 2 ns + 2 ns</li> </ul> |        | = 83 ns - 40 ns                                                                                    |
| \$114:        | <ul> <li>Min Address to AS - 74AS244 Max</li> <li>+ 74AS244 Min + 74AS32 Min</li> <li># 11 - Tphl Max + Tphl Min + Tphl Min</li> </ul>                                        |        | = 83 ns - 40 ns                                                                                    |

= ss + s0 + s1 + s2 - 68020 CLK Lowto AS Asserted - [(AREQ to RAS Negated) - (CLK to RAS Asserted)] = 2 Tcp16 - # 12 - \$50 = 125 ns - 30 ns - 16 ns = **79 ns @ 16 MHz** w/8420A-20 **w/8420A-20** = **81 ns @ 16 MHz** w/8420A-25 = 2 Tcp12 - #12 - \$50 = 166 ns - 30 ns - 16 ns = **120 ns @ 12 MHz** 

tRAC AND tCAC TIMING FOR DRAMs

Timing is supplied for the system shown in *Figure 7 (See Figure 8).* Since systems and DRAM times vary, the user is encouraged to change the following equations to match his system requirements. Timing has been supplied for systems with 1 or 2 wait states. If DELCLK is not a multiple of 2 MHz, the timing for tRAH and tASC will change and must be calculated and changed according to the equations in the DP8420A/21A/22A data sheet.

#### Port A

tRP

| 1 Wait State  |                                                                                                                                                                                                                                                                                                                                       |
|---------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| tRAC          | = s1 + s2 + sw + sw + s3 + s4  - 68020 CLK to AS Max - 74AS244  Delay Max - 74AS245 Delay Max  - 68020 Data Setup Min - ADS  Asserted to RAS Asserted  = Tcp16 + Tcp16 + Tcp16 - #9 Max  - TphI - TphI - #27 Min - \$402 Max  = 62.5 ns + 62.5 ns + 62.5 ns - 30 ns  - 6.2 ns - 7 ns - 5 ns - 29 ns                                   |
| [             | = 110 ns @ 16 MHz w/8420A-25<br>Heavy Load                                                                                                                                                                                                                                                                                            |
|               | = Tcp12 + Tcp12 + Tcp12                                                                                                                                                                                                                                                                                                               |
|               | = #9 Max - Tphl - Tphl<br>- #27 Min - \$402 Max                                                                                                                                                                                                                                                                                       |
|               | = 83.3 ns + 83.3 ns + 83.3 ns - 40 ns<br>- 6.2 ns - 7 ns - 10 ns -35 ns                                                                                                                                                                                                                                                               |
| [             | = 163 ns @ 12 MHz w/8420A-20<br>Heavy Load                                                                                                                                                                                                                                                                                            |
| 2 Wait States |                                                                                                                                                                                                                                                                                                                                       |
| tRAC          | = $s1 + s2 + sw + sw + s3 + s4$<br>- 68020 CLK to $\overline{AS}$ Max - 74AS244<br>Delay Max - 74AS245 Delay Max<br>- 68020 Data Setup Min - $\overline{ADS}$<br>Asserted to $\overline{RAS}$ Asserted<br>= Tcp16 + Tcp16 + Tcp16 + Tcp16<br>- #9 Max - Tphl - Tphl<br>#27 Min - \$402 Max<br>= 62.5 ns + 62.5 ns + 62.5 ns + 62.5 ns |
| г             | - 30 ns - 6.2 ns - 7 ns - 5 ns - 29 ns                                                                                                                                                                                                                                                                                                |
| L             | = 172.8 ns @ 16 MHz Heavy Load                                                                                                                                                                                                                                                                                                        |

= Tcp12 + Tcp12 + Tcp12 + Tcp12 - #9 Max - Tphi - Tphi - #27 Min - \$402 Max = 83.3 ns + 83.3 ns + 83.3 ns + 83.3 ns - 40 ns - 6.2 ns -7 ns - 10 ns -35 ns w/8420A-20 = 240 ns @ 12 MHz Heavy Load Port B 1 Wait State tRAC = s1 + s2 + sw + sw + s3 + s4- 68020 CLK to AS Max - 74AS32 Delay Max - 74AS244 Delay Max - 74AS245 Delay Max - 68020 Data Setup Min - AREQB Asserted to RAS Asserted = Tcp16 + Tcp16 + Tcp16 - #9 Max - TphI Max - TphI Max - TphI Max - #27 Min - \$102 Max = 62.5 ns + 62.5 ns + 62.5 ns - 30 ns- 6.2 ns - 5 ns - 7 ns - 5 ns - 34 ns w/8420A-25 = 110 ns @ 16 MHz Heavy Load = Tcp12 + Tcp12 + Tcp12 - #9 Max - Tphi Max - Tphi Max - Tphi Max - #27 Min - \$102 Max = 83.3 ns + 83.3 ns + 83.3 ns - 40 ns - 6.2 ns - 5 ns - 7 ns - 10 ns - 42 ns w/8420A-20 = 139 ns @ 12 MHz Heavy Load 2 Wait States tRAC = s1 + s2 + sw + sw + sw + sw- 68020 CLK to AS Max - 74AS32 Delay Max - 74AS244 Delay Max - 74AS245 Delay Max - 68020 Data Setup Min - AREQB Asserted to RAS Aserted = Tcp16 + Tcp16 + Tcp16 + Tcp16- #9 Max - Tphi Max TphI Max — TphI Max - #27 Min - \$102 Max = 62.5 ns + 62.5 ns + 62.5 ns + 62.5 ns - 30 ns - 6.2 ns - 5 ns - 7 ns - 5 ns - 34 ns w/8420A-25 = 167 ns @ 16 MHz Heavy Load = Tcp12 + Tcp12 + Tcp12 + Tcp12 - #9 Max - Tphi Max - Tphi Max - TphI Max - #27 Min - \$102 Max = 83.3 ns + 83.3 ns + 83.3 ns + 83.3 ns -40 ns - 6.2 ns - 5 ns - 7 ns - 10 ns -42 ns w/8420A-20 = 223 ns @ 12 MHz Heavy Load

| Port | A |  |
|------|---|--|
|      |   |  |

| FUILA         |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1 Wait State  |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| tCAC          | <ul> <li>= s1 + s2 + sw + sw + s3 + s4         <ul> <li>- 68020 CLK to AS Max - 74AS244</li> <li>Delay Max - 74AS245 Delay Max</li> <li>- 68020 Data Setup Min - ADS</li> <li>Asserted to CAS Asserted</li> </ul> </li> <li>= Tcp16 + Tcp16 + Tcp16 - #9 Max         <ul> <li>- TphI - TphI</li> <li>- #27 Min - \$403a Max</li> </ul> </li> <li>= 62.5 ns + 62.5 ns - 30 ns</li> <li>= 62 stars - 5 and stars - 5 and stars</li> </ul> |
|               | - 6.2 ns - 7 ns - 5 ns - 82 ns                                                                                                                                                                                                                                                                                                                                                                                                          |
|               | = 57 ns @ 16 MHz Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                             |
|               | = Tcp12 + Tcp12 + Tcp12 = #9 Max<br>- TphI - TphI - #27 Min<br>- \$403a Max                                                                                                                                                                                                                                                                                                                                                             |
|               | = 83.3 ns + 83.3 ns + 83.3 ns -40 ns<br>- 6.2 ns - 7 ns - 10 ns - 94 ns<br>w/8420A-20                                                                                                                                                                                                                                                                                                                                                   |
|               | = 92 ns @ 12 MHz Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                             |
| 2 Wait States |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| tCAC          | $= s1 + S2 + sw + sw + sw + sw + s3 + s4 - 68020 CLK to \overline{AS} Max - 74AS244 Delay Max - 74AS245 Delay Max - 68020 Data Setup Min - \overline{ADS} Asserted to \overline{CAS} Asserted = Tcp16 + Tcp16 + Tcp16 + Tcp16 - #9 Max - Tphl - Tphl - #27 Min - $403a Max = 62.5 ns + 62.5 ns + 62.5 ns + 62.5 ns - 30 ns - 6.2 ns - 7 ns - 5 ns - 82 ns w/8420A-25$                                                                   |
|               | = 119 ns @ 16 MHz Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                            |
|               | = Tcp12 + Tcp12 + Tcp12 + Tcp12<br>- #9 Max - Tphl - Tphl<br>- #27 Min - \$403a Max<br>= 83.3 ns + 83.3 ns + 83.3 ns + 83.3 ns                                                                                                                                                                                                                                                                                                          |
|               | - 40 ns - 6.2 ns - 5 ns - 7 ns<br>- 10 ns - 94 ns                                                                                                                                                                                                                                                                                                                                                                                       |
|               | = 10 hs = 94 hs<br>= 171 ns @ 12 MHz<br>Heavy Load                                                                                                                                                                                                                                                                                                                                                                                      |
|               |                                                                                                                                                                                                                                                                                                                                                                                                                                         |

### Port B

1 Wait State tCAC

| tCAC          | = s1 + s2 + sw + sw + s3 + s4<br>- 68020 CLK to <del>AS</del> Max - 74AS32<br>Delay Max - 74AS244 Delay Max<br>- 74AS245 Delay Max - 68020 Data<br>Setup Min - <del>AREQB</del> Asserted<br>to <del>CAS</del> Asserted<br>= Tcp16 + Tcp16 + Tcp16<br>- #9 Max - TphI - TphI - TphI<br>- #27 Min - \$118                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|               | = 62.5 ns + 62.5 ns + 62.5 ns<br>- 30 ns - 5 ns - 6.2 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|               | - 7 ns - 5 ns - 88 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|               | = 46 ns @ 16 MHz w/8420A-25<br>Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|               | = Tcp12 + Tcp12 + Tcp12                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|               | = #9 Max - TphI - TphI - TphI                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|               | – #27 Min – \$118a                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|               | = 83.3  ns + 83.3  ns + 83.3  ns - 40  ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|               | -5  ns - 6.2  ns - 7  ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|               | - 10 ns - 103 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|               | w/8420A-20                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|               | = 78 ns @ 12 MHz                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|               | = 78 hs @ 12 MHz Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 2 Wait States | Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 2 Wait States | Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|               | Heavy Load                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|               | Heavy Load<br>= s1 + s2 + sw + sw + sw + sw + s3<br>+ s4 - 68020 CLK to AS Max                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|               | Heavy Load<br>= s1 + s2 + sw + sw + sw + sw + s3<br>+ s4 - 68020 CLK to AS Max<br>- 74AS32 Delay Max - 74AS244 Delay                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|               | Heavy Load<br>= s1 + s2 + sw + sw + sw + sw + s3<br>+ s4 - 68020 CLK to AS Max<br>- 74AS32 Delay Max - 74AS244 Delay<br>Max - 74AS245 Delay Max                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|               | Heavy Load<br>= s1 + s2 + sw + sw + sw + sw + s3<br>+ s4 - 68020 CLK to AS Max<br>- 74AS32 Delay Max - 74AS244 Delay                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|               | Heavy Load<br>Heavy |
|               | Heavy Load<br>= s1 + s2 + sw + sw + sw + s3<br>+ s4 - 68020 CLK to ĀS Max<br>- 74AS32 Delay Max - 74AS244 Delay<br>Max - 74AS245 Delay Max<br>- 68020 Data Setup Min - ĀREQB<br>Asserted to CAS Asserted<br>= Tcp16 + Tcp16 + Tcp16 + Tcp16                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|               | Heavy Load<br>Heavy Load<br>$= s1 + s2 + sw + sw + sw + s3$ $+ s4 - 68020 CLK to \overline{AS} Max$ $- 74AS32 Delay Max - 74AS244 Delay Max$ $- 68020 Data Setup Min - \overline{AREQB}$ Asserted to $\overline{CAS}$ Asserted<br>= Tcp16 + Tcp16 + Tcp16 + Tcp16 $- #9 Max - Tphl - Tphl - Tphl$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|               | $= s1 + s2 + sw + sw + sw + sw + s3$ $+ s4 - 68020 CLK to \overline{AS} Max$ $- 74AS32 Delay Max - 74AS244 Delay Max$ $- 68020 Data Setup Min - \overline{AREQB}$ Asserted to $\overline{CAS}$ Asserted<br>= Tcp16 + Tcp16 + Tcp16 + Tcp16 $- #9 Max - Tphl - Tphl - Tphl$ $- #27 Min - $118a Max$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|               | Heavy Load<br>= $s1 + s2 + sw + sw + sw + sw + s3$<br>+ $s4 - 68020$ CLK to $\overline{AS}$ Max<br>- $74AS32$ Delay Max - $74AS244$ Delay<br>Max - $74AS245$ Delay Max<br>- $68020$ Data Setup Min - $\overline{AREQB}$<br>Asserted to $\overline{CAS}$ Asserted<br>= Tcp16 + Tcp16 + Tcp16 + Tcp16<br>- $\#9$ Max - Tphl - Tphl - Tphl<br>- $\#27$ Min - $\$118a$ Max<br>= $62.5$ ns + $62.5$ ns + $62.5$ ns - $30$ ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|               | Heavy Load<br>Heavy |
|               | Heavy Load<br>Heavy Load<br>s = s1 + s2 + sw + sw + sw + s3 + s4 - 68020 CLK to AS Max - 74AS32 Delay Max - 74AS244 Delay Max - 74AS245 Delay Max - 68020 Data Setup Min - AREQB Asserted to CAS Asserted Top16 + Top16 + Top16 + Top16 + Top16 - #9 Max - TphI - TphI - TphI - TphI - #27 Min - \$118a Max = 62.5 ns + 62.5 ns + 62.5 ns - 30 ns - 5 ns - 6.2 ns - 5 ns - 7 ns - 5 ns - 84 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|               | Heavy Load<br>= s1 + s2 + sw + sw + sw + s3<br>+ s4 - 68020 CLK to $\overline{AS}$ Max<br>- 74AS32 Delay Max - 74AS244 Delay<br>Max - 74AS245 Delay Max<br>- 68020 Data Setup Min - $\overline{AREQB}$<br>Asserted to $\overline{CAS}$ Asserted<br>= Tcp16 + Tcp16 + Tcp16 + Tcp16<br>- #9 Max - TphI - TphI - TphI<br>- #27 Min - \$118a Max<br>= 62.5 ns + 62.5 ns + 62.5 ns - 30 ns<br>- 5 ns - 6.2 ns - 5 ns - 7 ns<br>- 5 ns - 84 ns<br>= 109 ns @ 16 MHZ<br>w/8420A-25                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|               | Heavy Load<br>Heavy Load<br>s = s1 + s2 + sw + sw + sw + s3 + s4 - 68020 CLK to AS Max - 74AS32 Delay Max - 74AS244 Delay Max - 74AS245 Delay Max - 68020 Data Setup Min - AREQB Asserted to CAS Asserted Top16 + Top16 + Top16 + Top16 + Top16 - #9 Max - TphI - TphI - TphI - TphI - #27 Min - \$118a Max = 62.5 ns + 62.5 ns + 62.5 ns - 30 ns - 5 ns - 6.2 ns - 5 ns - 7 ns - 5 ns - 84 ns                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |

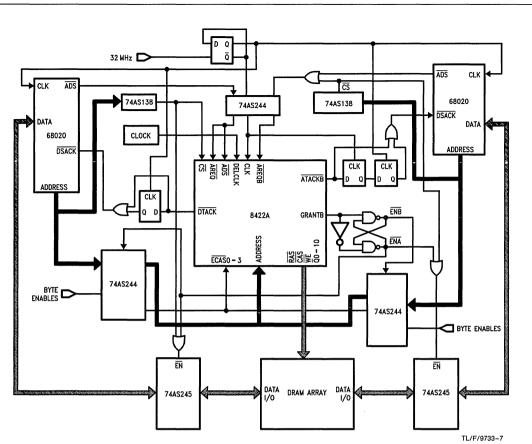
= Tcp12 + Tcp12 + Tcp12 + Tcp12 - #9 Max - Tphl - Tphl - Tphl - #27 Min - \$118 Max

= 162 ns @ 12 MHz

= 83.3 ns + 83.3 ns + 83.3 ns + 83.3 ns - 40 ns - 5 ns - 6.2 ns - 7 ns - 10 ns - 103 ns

w/8420A-20

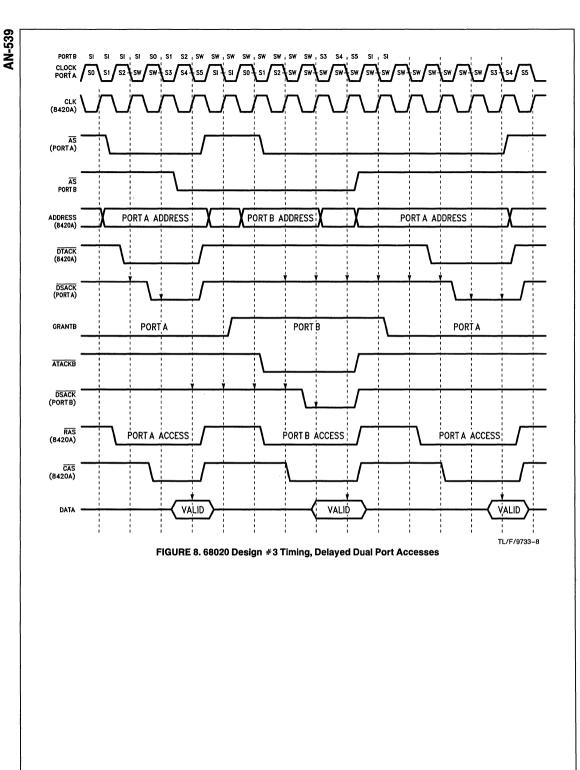
Heavy Load

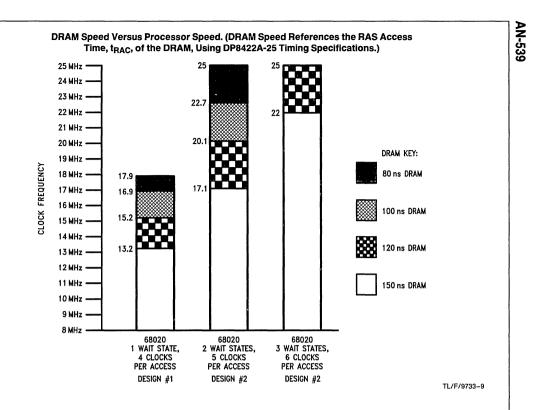


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## Interfacing the DP8422A to the 68020 (Zero Wait State Burst Mode Access)

#### INTRODUCTION

This application note describes interfacing the DP8422A DRAM controller (also applicable to DP8420A/21A) to the 68020 with slower memories. This design is based upon burst mode access by holding  $\overline{\text{RAS}}$  low and toggling  $\overline{\text{CAS}}$ . It is assumed that the user is familiar with the DP8422A and 68020 mode operations.

#### **DESIGN DESCRIPTION**

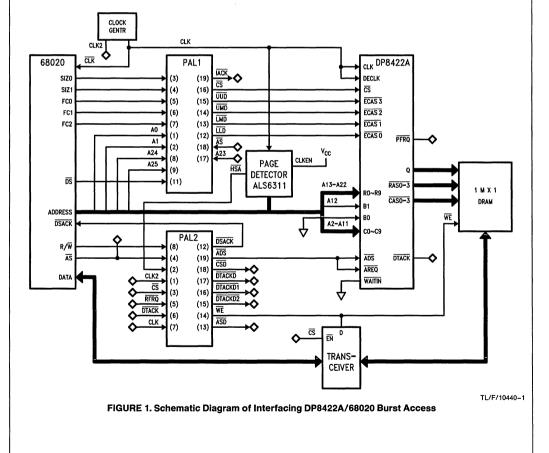
This design consists of the DP8422A DRAM controller, two PALs (16R4D and 16L8D), and a page detector (ALS6311). This design accommodates two banks of DRAM, each bank being 32 bits in width, giving maximum memory capacity of either 8 Mbytes (using 1M x 1 DRAMs) or 32 Mbytes (using 4M x 1 DRAMs). This design is based on 1M x 1 DRAM running at 16 MHz clock. The schematic diagram of interfacing DP8422A to the 68020 is shown in *Figure 1*. The

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DP8422A is operated in Mode 1. An access cycle begins when the 68020 places a valid address on the address bus and asserts the Address Strobe  $(\overline{AS})$  if a refresh or Port B access (DP8422A only) is not in progress. The proper RAS and CAS will be asserted respectively, depending upon programming bits C6, C5, and C4 for RAS and CAS configuration after guaranteeing the programmed value of row address hold time and the column address setup time.

The High Speed Access (HSA) output signal of page detector indicates whether the current access is in the same page as previous access or not.  $\overline{\text{ADS}}$  (AREQ) is kept low if the current access is in the page, otherwise  $\overline{\text{ADS}}$  (AREQ) will be forced to go high to terminate the burst access. Internal refresh logic automatically generates refresh request every 15  $\mu$ s. The timing diagrams are shown in *Figure 2* and *Figure 3*.



#### **DP8422A PROGRAMMING BITS**

| u = User De         | efined    |                                  |
|---------------------|-----------|----------------------------------|
| Programming<br>Bits |           | Description                      |
| R0, R1              | = 0, 1    | RAS High and Low Times           |
| R2, R3              | = 0, 0    | DTACK Generation Mode            |
|                     |           | for Nonburst Access              |
| R4, R5              | = 0, 0    | DTACK Generation Mode            |
|                     |           | for Burst Access                 |
| R6                  | = 0       | Add Wait States if WAITIN is Low |
| R7                  | = 1       | DTACK Mode Select                |
| R8                  | = 1       | Noninterleave Mode               |
| R9                  | = u       | All RAS's or Staggered           |
|                     |           | Refresh Select                   |
| C0, C1, C2          | = 0, 1, 0 | Refresh Clock Divisor Select     |
| C3                  | = 0       | Refresh Clock Divider Select     |
| C4, C5, C6          | = 0, 0, 1 | RAS and CAS Configuration        |
|                     |           | Mode                             |
| C7                  | = 1       | tASC Mode Select                 |
| C8                  | = 1       | t <sub>RAH</sub> Mode Select     |
| C9                  | = u       | Delay CAS during Write           |
|                     |           | Access Mode Select               |
| B0                  | = 1       | Fall through Mode                |
| B1                  | = 1       | Mode 1 Access                    |
| ECAS0               | = 1       | Extend CAS and Refresh Request   |

#### **DESIGN TIMING PARAMETERS**

= 13.5 ns

Timing parameters are referenced to the numbers shown in the DP8422A data sheet timing parameters. Numbered times starting with a "\$" refer to DP8422A timing parameters. Numbered times starting with a "#" refer to 68020 timing parameters.

16 MHz t<sub>CP</sub> = 62.5 ns \$400: ADS Asserted Setup to CLK 1/2 t<sub>CP</sub> - PAL t<sub>CLK</sub> Max. = 31.25 ns - 8 ns = 23.25 ns \$401: CS Setup to ADS Asserted 2 t<sub>CP</sub> + PAL t<sub>CLK</sub> Min. - #6 CLK to Address Valid - PAL tp Max. = 125 ns + 5.5 ns - 30 ns - 10 ns= 90.5 ns AREQ Negated to ADS Asserted \$416: t<sub>CP</sub> - (PAL t<sub>CLK</sub> Max. - PAL t<sub>CLK</sub> Min.) = 62.5 ns - 2.5 ns = 60 ns #47: DTACK (68020) Low Setup to CLK Low 1/2 t<sub>CP</sub> - PAL t<sub>CLK</sub> Max. - PAL t<sub>p</sub> Max. = 31.25 ns - 8 ns - 10 ns

(Nonburst Access): t<sub>RAC</sub>  $3~t_{CP}$  - PAL  $t_{CLK}$  Max. - PAL  $t_p$  Max. - \$402 ADS Low to RAS Low - #27 Data Setup -F245 Transceiver tp Max. = 187.5 ns - 8 ns - 10 ns - 29 ns - 5 ns - 6 ns = 129.5 ns (-25 Part) = 187.5 ns - 8 ns - 10 ns - 35 ns - 5 ns - 6 ns = 123.5 ns (-20 Part) (Nonburst Access): t<sub>CAC</sub> 3 t<sub>CP</sub> - PAL t<sub>CLK</sub> Max. - PAL t<sub>p</sub> Max. - \$403a ADS Low to CAS Low - #27 Data Setup -F245 Transceiver to Max. = 187.5 ns - 8 ns - 10 ns - 82 ns - 5 ns - 6 ns = 76.5 ns (-25 Part) = 187.5 ns - 8 ns - 10 ns - 94 ns - 5 ns - 6 ns = 64.5 ns (-20 Part) t<sub>AA</sub> (Nonburst Access): 3 t<sub>CP</sub> - PAL t<sub>CLK</sub> Max. - PAL t<sub>p</sub> Max. - \$417 ADS Low to Column Address Valid - #27 Data Setup - F245 Transceiver to Max. = 187.5 ns - 8 ns - 10 ns - 78 ns - 5 ns - 6 ns = 80.5 ns (-25 Part) = 187.5 ns - 8 ns - 10 ns - 92 ns - 5 ns - 6 ns = 66.5 ns (-20 Part) (Burst Access): tCAC 2 t<sub>CP</sub> - #9 CLK High to DS Low Max. - PAL t<sub>p</sub> Max. - \$14 ECAS Low to CAS Low Max. - #27 Data Setup - F245 Transceiver to Max. = 125 ns - 30 ns - 10 ns - 27 ns - 5 ns - 6 ns = 47 ns (-25 Part) = 125 ns - 30 ns - 10 ns - 31 ns - 5 ns - 6 ns = 43 ns (-20 Part) (Burst Access): t<sub>AA</sub> 3.5 t<sub>CP</sub> - #6 CLK Low to Address Valid Max. -\$26 Address Valid to Q Max. - #27 Data Setup F245 Transceiver t<sub>p</sub> Max. = 218.75 ns - 30 ns - 35 ns - 5 ns - 6 ns = 142.75 ns (-25 Part) = 218.75 ns - 30 ns - 38 ns - 5 ns - 6 ns = 139.75 ns (-20 Part) AN-616

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# **AN-616**

### 20DAL FOUATIONS

| 68020PAL EQUATIONS                        |                                                                                                             |  |
|-------------------------------------------|-------------------------------------------------------------------------------------------------------------|--|
| The Boolean entry operators are listed as |                                                                                                             |  |
| ":=" Repla                                | ced by (After Clock)                                                                                        |  |
| "=" Equal                                 | ity                                                                                                         |  |
| "*" AND                                   |                                                                                                             |  |
| "+" OR                                    |                                                                                                             |  |
| "/" Comp                                  | lement                                                                                                      |  |
| "∼" Active                                | low                                                                                                         |  |
| The brief exp                             | planation of PAL output signals                                                                             |  |
| CS~                                       | This combinational output signal is Chip Select.                                                            |  |
| CSD~                                      | This sequential output signal is Chip Select Delayed by one clock.                                          |  |
| ADS~                                      | This sequential output signal is Address<br>Strobe (also used as an Access Request, /<br>AREQ, to DP8422A). |  |
| DTACKD~                                   | This sequential output signal is Data Transfer<br>Delayed by one clock.                                     |  |
| DTACKD1~                                  | This sequential output signal is Data Transfer<br>Delayed by two clocks.                                    |  |
| DTACKD2~                                  | This sequential output signal is Data Transfer<br>Delayed by three clocks.                                  |  |
| WE~                                       | This sequential output signal is Write Enable to DRAM.                                                      |  |
| DSACK~                                    | This combinational output signal is Data Transfer and Size Acknowledge.                                     |  |
| UUD~                                      | This combinational output signal is to select upper upper byte.                                             |  |
| UMD~                                      | This combinational output signal is to select upper middle byte.                                            |  |
| LMD~                                      | This combinational output signal is to select lower middle byte.                                            |  |
| LLD~                                      | This combinational output signal is to select lower lower byte.                                             |  |
| IACK~                                     | This combinational output signal is interrupt acknowledge.                                                  |  |

### (I) PAL1 (PAL16L8D) EQUATIONS

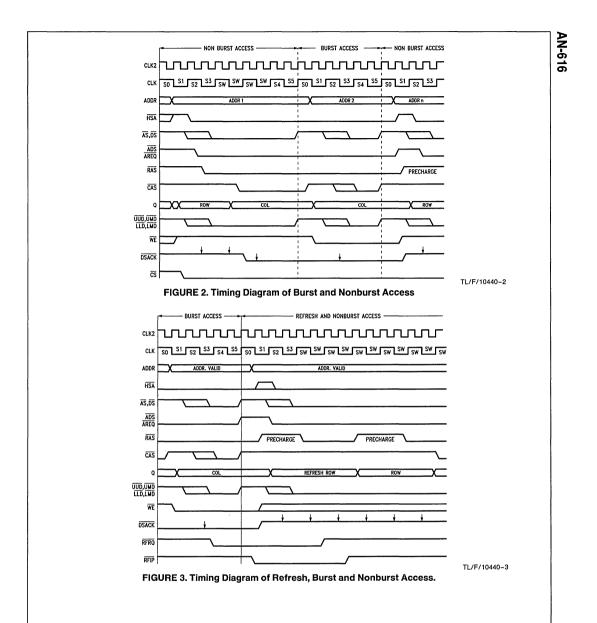
Inputs: A0, A1, A23, A24, A25, FC2, FC1, FC0, SIZ0, SIZ1, DS~, AS~

### Outputs:

- = /FC2 + /FC1 + /FC0 /IACK~ /CS~ = /A23 \* /A24 \* /A25 \* /FC2 \* /FC1 \* FC0 + /A23 \* /A24 \* /A25 \* /FC2 \* FC1 \* /FC0 + /A23 \* /A24 \* /A25 \* FC2 \* /FC1 \* FC0 + /A23 \* /A24 \* /A25 \* FC2 \* FC1 \* /FC0
- /UUD~ = /A0 \* /A1 \* /DS~ \* /AS~ /UMD~ = /SIZ0 \* /A1 \* /DS~ \* /AS~ + A0 \* /A1 \* /DS~ \* /AS~ + SIZ1 \* /A1 \* /DS~ \* /AS~
- = /A0 \* /A1 \* /DS~ \* /AS~ + /A1 \* /LMD~ /SIZ0 \* /SIZ1 \* /DS~ \* /AS~ + SIZ1 \* SIZ0 /A1 \* /DS~ \* /AS~ + /SIZ0 \* /A1 \* A0 \* /DS~ \* /AS~
- /LLD~ = A0 \* SIZ0 \* SIZ1 \* /DS~ \* /AS~ + /SIZ0 \* /SIZ1 \* /DS~ \* /AS~ + A0 \* A1 \* /DS~ \* /AS~ + A1 \* SIZ1 \* /DS~ \* /AS~

### (II) PAL2 (PAL16R6D) EQUATIONS

- Inputs: CLK2, CS~, HSA~, AS~, RFRQ~, DTACK~, CLK, RW~
  - /ADS~ = /HSA ~ \* /ASD ~
  - /DSACK~ = /DTACK~ \* /DTACKD~
  - /DTACKD~ := /DTACK~ \* /CLK + /DTACKD~ \* CLK
- /DTACKD1~ := /DTACKD~ \* /CLK + /DTACKD1~ \* CLK
- /DTACKD2~ := /DTACKD1~ \* /CLK + /DTACKD2~ \* CLK
- /ASD~ := /CSD~ \* CLK /AS~ + /CSD~ \* /HSA~ \* /AS~ + /CSD~ \* /RFRQ~ \* /AS~ + /RFRQ~ \* CSD~ \* /AS~ + /RFRQ~ \* CLK \* /AS~ + /RFRQ~ \* /HSA~ \* /AS~ + /CSD~ \* CLK \* RFRQ~ + /CSD~ \* /HSA~ \* RFRQ~ /WE~ := /RW~ \* AS~ \* CLK + /WE~ \* /CLK
- := /CS~ \* /CLK + /CSD~ \* CLK /CSD~
- Note: PAL1 address inputs, such as A23, A24 and A25, are system memory size dependent.



# Interfacing the DP8422A to an Asynchronous Port B in a Dual 68020 System

### INTRODUCTION

This application note explains interfacing the DP8422A DRAM controller to two 68020 microprocessors that are running at the same frequency, but asynchronously to each other. This application note is a supplement to AN-539 (Interfacing the DP8420A/21A/22A to the 68020) and is intended to show synchronization logic and timing requirements for a Port B CPU that is running asynchronous to the DP8422A. It is assumed that the reader is already familiar with the 68020 access cycles and the DP8422A modes of operation.

### **DESIGN DESCRIPTION**

This design shows all of the logic necessary to interface an asynchronous 20 MHz 68020 to the DP8422A Port B control inputs. This design is a worst case example and includes some logic that would not be needed in slower systems (i.e., 68000 @ 10 MHz). In our example, a Port B access begins when the asynchronous 68020 places a valid address on the address bus and asserts the address strobe,  $\overline{AS}$ . In order to synchronize this signal to the DP8422A, it is run through two DQ flip-flops, which are clocked by Port A's input clock. The first DQ is run by an inverted clock in order to reduce the synchronization delay time by 1/2T. Once  $\overline{AREQB}$  is asserted, the access request is latched on the DP8422A and an access will start. If GRANTB is asserted, signaling Port B control of the access port, and a refresh is not in progress, the DP8422A will assert an access  $\overline{RAS}$ .

The transfer acknowledge signal,  $\overline{\text{ATACKB}}$  is also asserted from  $\overline{\text{AREQB}}$  asserting (or from the same edge of clock that starts RAS for a delayed access).  $\overline{\text{AREQB}}$  also runs through two DQ flip-flops before being input as DSACK to the 68020B. These two flip-flops serve a dual purpose, one being to synchronize the  $\overline{\text{ATACKB}}$  signal to the 68020B clock, and the other is to provide 1T of delay for the  $\overline{\text{ATACKB}}$ signal. National Semiconductor Application Note 617 Chris Koehle



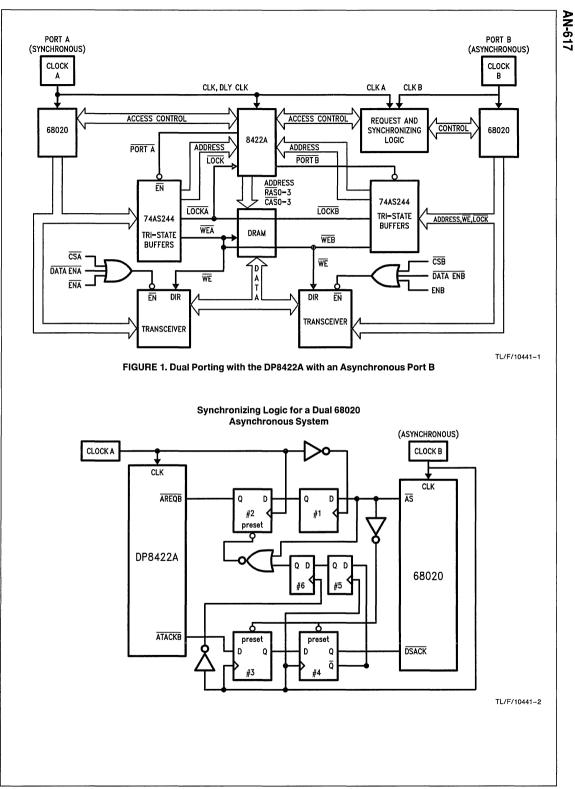
Once DSACK is sampled as asserted by the 68020. AS is negated, signifying an end to the present access. AS negating is used to negate the DSACK input by presetting the two flip-flops connected to this input. This is done to guarantee that the 68020B DSACK signal is negated prior to the next access request being valid. The "Q" output that is connected to the DSACK input on the 68020 is also run through 11/3T of delay (2DQ's) before it is used to preset the flip-flop that drives AREQB. The preset is used to negate the AREQB signal and to hold it negated for the required AREQB negated pulse width as specified by the DP8422A. AS is also used to preset this signal so AREQB does not get asserted in instances where there are not back-to-back accesses. The 11/2T delay is used so that the AREQB signal is negated after data is sampled by the 68020. In addition to the parameters calculated in AN-539, these additional parameters are included to show how the synchronizing logic still meets the necessary setup times required by the system (the "\$" symbol refers to a DP8422A parameter, and the "#" symbol refers to a 68020 parameter).

- \$101 AREQB Asserted Setup to CLK High
  - (The DP8422A-25 needs 7 ns)
    - = 1 T<sub>CP</sub>  $t_{PHL}$  (74F74 DQ Flip-Flop) = 50 ns - 8 ns

#47a DSACK Asserted Setup Time (68020 needs 5 ns)

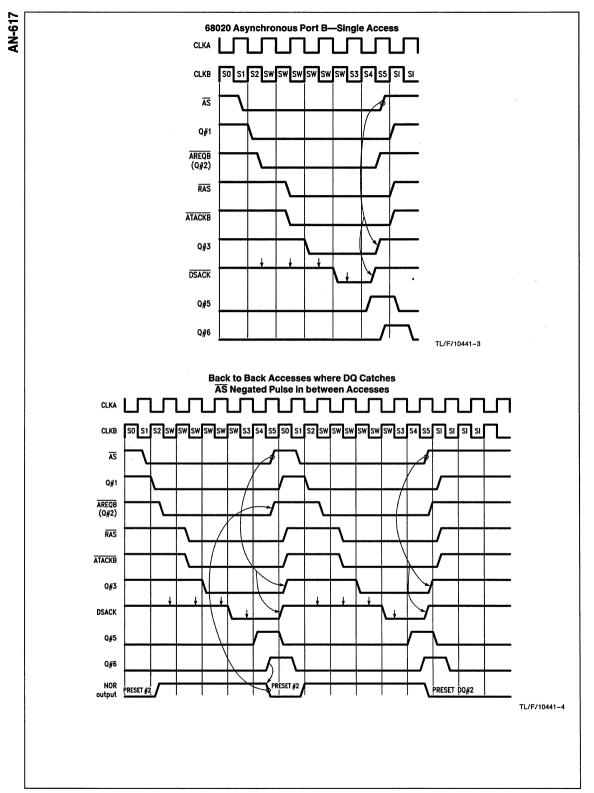
- 1/2 T<sub>CP</sub> t<sub>PHL</sub> (74F74) 25 ns - 8 ns
- 17 ns

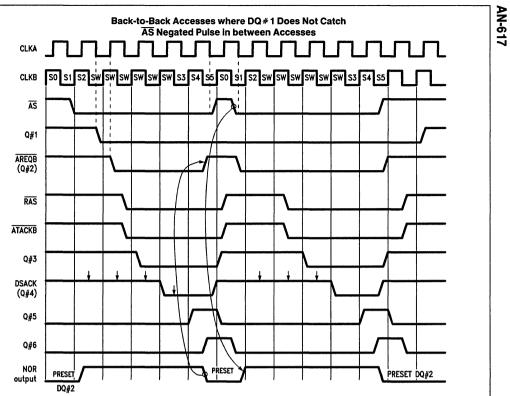
AS negated pulse width guarantees the DP8422A meets AREQB negated pulse width (\$117) through the preset of DQ flip-flop which is connected to AREQB input.



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# Interfacing the DP8420A/21A/22A to the 68030 Microprocessor

### I. INTRODUCTION

This application note describes how to interface the 68030 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). It is assumed that the reader is already familiar with 68030 and the DP8422A modes of operation.

### II. DESCRIPTION OF DESIGN, ALLOWING UP TO 25 MHz OPERATION WITH 2, 3 OR 4 WAIT STATES IN NORMAL ACCESSES AND 1 OR 2 WAIT STATES DURING BURST ACCESSES

This design drives two banks of DRAM, each bank being 32 bits in width, giving a maximum memory capacity of 32 Mbytes (using 4 Mbit x 1 DRAMs). By choosing a different RAS and CAS configuration mode (See Programming Mode Bits Section of DP8422A Data Sheet) this application can support 4 banks of DRAM, giving a memory capacity of 64 Mbytes (using 4 Mbit x 1 DRAMs, NOTE that when driving 64 Mbytes the timing calculations will have to be adjusted to the greater capacitive load).

The memory banks are interleaved on every four word (32-bit word) boundry. This means that the address bit (A4) is tied to the bank select input of the DP8422A (B1). Address bits A3, 2 are tied to the highest row and column address inputs to support nibble mode burst accesses (using nibble mode DRAMs). Address bits A1. 0 are used to produce the four byte select data strobes, used in byte reads and writes. If the majority of accesses made by the 68030 are sequential, the 68030 can be doing burst accesses most of the time. Each burst of four words can alternate memory banks, allowing one memory bank to be precharging (RAS precharge) while the other bank is being accessed. This is a higher performance memory system then a non-interleaved memory system (bank select on the higher address bits). Each separate memory access to the same memory bank will generally require extra wait states to be inserted into the CPU access cycles to allow for the RAS precharge time.

This design supports the 68030 in its synchronous mode of operation. All DRAM accesses are terminated through the 68030 STERM input. The burst mode transfer operations are also supported using the synchronous mode of operation. To support these operations nibble mode DRAMs must be used. Nibble mode DRAMs are necessary to support wrap-around during a burst access.

This application allows 2, 3 or 4 wait states to be inserted in normal synchronous accesses and 1 or 2 wait states to be inserted during burst accesses of the 68030. The number of wait states can be adjusted through the WAITIN input of the

National Semiconductor Application Note 537 Webster (Rusty) Meier Jr. and Joe Tate



DP8422A and the ADDW input of the PAL®, see the table below (the first two rows of the table can also be seen in the timing simulations that appear at the end of this application note):

| WAITIN | ADDW | Number of Wait States In |              |  |
|--------|------|--------------------------|--------------|--|
|        |      | Normal Access            | Burst Access |  |
| 0      | 0    | 4                        | 2            |  |
| 0      | 1    | 3                        | 1            |  |
| 1      | 0    | 3                        | 2            |  |
| 1      | 1    | 2                        | 1            |  |

The PAL has an input called "EXST" that allows the user to setup the STERM for any other system peripheral to this PAL. This PAL will synchronize EXST to the system clock by gating it with a low logic level on the CLK input (for more information see the PAL equations in Section V). This allows one device to produce STERM to the 68030.

The logic shown in this application note forms a complete 68030 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- a. Arbitration between Port A, Port B, and refreshing the DRAM;
- b. The insertion of wait states to the processor (Port A and Port B) when needed (i.e, if RAS precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access . . . etc.);
- c. Performing byte writes and reads to the 32-bit words in memory;
- d. Normal and burst access operations.

By making use of the enable input on the 74AS244 buffer, this application can easily be used in a dual access application. The addresses and chip select are tri-stated through this buffer, the write input (WIN), lock input (COCK), and ECAS0–3 inputs must also be able to be tri-stated (another 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B) the DP8422A can be used in a dual access application. If this design is used in a dual access application at 25 MHz the  $t_{\rm RAC}$  and  $t_{\rm CAC}$  (require RAS and CAS access time required by the DRAM) will have to be recalculated since the time to RAS and CAS is longer for the dual access application (See TIMING Section of this application note).

### III. 68030 DESIGN, UP TO 25 MHz WITH 2, 3 OR 4 WAIT STATES DURING NORMAL ACCESSES AND 1 OR 2 WAIT STATES DURING BURST ACCESSES, PROGRAM-MING MODE BITS

Programming Bits Description R0 = 1RAS low four clocks. RAS precharge of three clocks R1 = 1R2 = 1DTACK1 is chosen. DTACK low first rising CLK edge after access RAS is low. No WAIT states during burst accesses R4 = 0R5 = 0R6 = 0If  $\overline{WAITIN} = 0$ , add one clock to  $\overline{DTACK}$ . WAITIN may be tied high or low in this application depending upon the number of wait states the user desires to insert into the access R7 = 1 Select DTACK R8 = 1Non-Interleaved Mode R9 = XC0 = XSelect based upon the input "DELCLK" fre-C1 = Xquency. Example: if the input clock frequency C2 = Xis 20 MHz then choose C0, 1, 2 = 0, 0, 0(divide by ten, this will give a frequency of 2 MHz). If using the DP8422A over 20 MHz do an initial divide by two externally and then run that output into the DELCLK input and choose the correct divider. C3 = XC4 = 0RAS groups selected by "B1". This mode al-C5 = 0lows two RAS outputs to go low during an C6 = 1 access, and allows byte writing in 32-bit words. C7 = 1Column address setup time of 0 ns. C8 = 1 Row address hold time of 15 ns. C9 = 1Delay CAS during write accesses to one clock after RAS transitions low B0 = 1Fall-thru latches B1 = 1 Access mode 1  $\overline{\text{ECASO}} = 0$   $\overline{\text{CAS}}$  not extended beyond  $\overline{\text{RAS}}$ 

- 0 = Program with low voltage level1 = Program with high voltage level
- X = Program with either high or low voltage level
- (don't care condition)

### IV. 68030 TIMING CALCULATIONS FOR DESIGN AT 25 MHz WITH 4 WAIT STATES DURING THE NORMAL ACCESSES AND 2 WAIT STATES DURING BURST AC-CESSES

1. Minimum ADS low setup time to CLOCK high for DTACK logic to work correctly (DP8422A-25 needs 25 ns):

40 ns (one clock period) - 10 ns (PAL16R4D combinational output max) = 30 ns

2A. Minimum address setup time to ADS low (DP8422A-25 needs 14 ns):
40 ns (one clock period) - 20 ns (assumed 68030 max time to address valid from CLK high) - 6.2 ns

(74AS244 buffer delay max) + 2.5 ns (minimum PAL16R4D combinational output delay) = 16.3 ns

2B. Minimum address setup time to CLK high (used in #3B calculation below):
40 ns (one clock period) - 20 ns (assumed 68030 max

time to address valid from CLK high) - 6.2 ns (74AS244 buffer delay max) = 13.8 ns

- 3A. Minimum CS setup time to ADS low (DP8422A-25 needs 5 ns):
  - 16.3 ns (#2A) 9 ns (max 74AS138 decoder) = 7.3 ns
- 3B. Minimum CS setup time to CLK high (PAL equations need 0 ns):

13.8 ns (#2B) - 9 ns (max 74AS138 decoder) = 4.8 ns

4. Determining  $t_{RAC}$  during a normal access (RAS access time needed by the DRAM):

180 ns (four and one half clock periods to do the access) - 10 ns (PAL16R4D combinational output,  $\overline{\text{ADS}}$ ) - 29 ns ( $\overline{\text{ADS}}$  to  $\overline{\text{RAS}}$  low) - 5 ns (68030 data setup time) - 7 ns (74F245) = 129 ns.

Therefore the  $t_{RAC}$  of the DRAM must be 129 ns or less.

 Determining t<sub>CAC</sub> during a normal access (CAS access time) and column address access time needed by the DRAM:

180 ns - 10 ns - 5 ns - 7 ns - 75 ns (ADS to CAS low on DP8422A-25, 50 pF spec) -12 ns [74AS32, 6 ns plus 6 ns extra, taken from lab data on the 74AS32, for driving a 22 $\Omega$  damping resister and 150 pF of capacitance associated with driving 16 DRAM CAS inputs (per CAS output)] = 71 ns.

Therefore the  $t_{CAC}$  of the DRAM must be 71 ns or less.

6. Determining the nibble mode access time needed during a burst access:

120 ns (three clock periods to do the burst) -20 ns (one half clock period during which  $\overrightarrow{CAS}$  is high from the previous access) -20 ns (the data is sampled on a faling clock edge) -10 ns (PAL16R4D combinational output from CLK input falling edge,  $\overrightarrow{ENCAS}$  -12 ns (74AS32 delay to produce  $\overrightarrow{CAS}$  from the  $\overrightarrow{ENCAS}$  input, see discription from #5) -5 ns (68030 data setup time) -7 ns (74F245) = 46 ns.

Therefore the nibble mode access time of the DRAM must be 46 ns or less.

7. Maximum time to DTACK2 low (PAL16RD needs 10 ns setup to CLK):

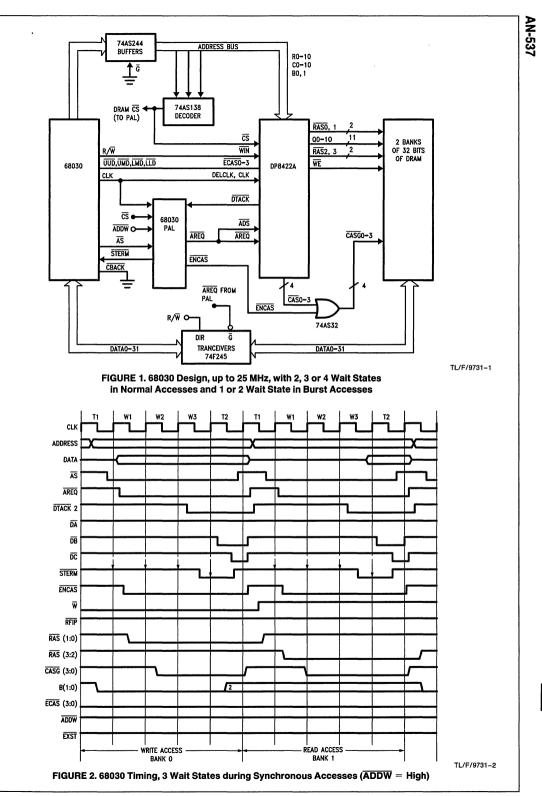
40 ns (One clock) - 28 ns (DTACK2 low from CLK high on DP8422A-25) = 12 ns

8. Minimum STERM setup time to CLK (0 ns to CLK rising edge is needed by the 68030):

20 ns (one half clock period) - 10 ns (PAL16R4D combinational output maximum) = 10 ns

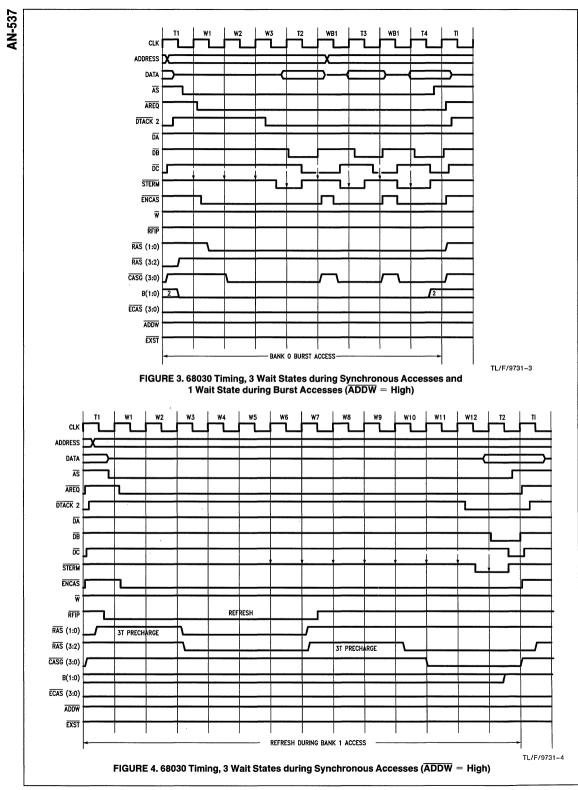
\*\* Note: That calculations can be performed for different frequencies and/ or different combinations of wait states by substituting the appropriate values into the above equations. **AN-537** 

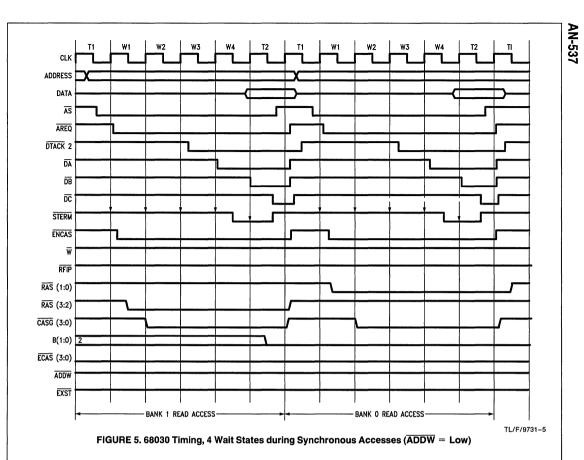
V. 68030 Design, PAL Equations Written in National Semiconductor PLAN™ Format PAL16R4D BCLK CS AS NC1 DTACK EXST ADDW CLK NC2 GND OE STERM DC NC3 DB DA NC4 ENCAS AREQ VCC IF (VCC)  $\overline{AREQ} = \overline{AS} * \overline{CS} * CLK$ + AREQ \* CS \* CLK IF (VCC)  $\overline{\text{ENCAS}} = \overline{\text{AREQ}} * \overline{\text{CS}} * \text{DC}$ + AREQ \* CS \* CLK IF (VCC)  $\overline{\text{DC}} = \overline{\text{AS}} * \overline{\text{CS}} * \overline{\text{DB}} * \overline{\text{CLK}}$ +  $\overline{\text{AS}}$  \*  $\overline{\text{CS}}$  \*  $\overline{\text{DC}}$  \* CLKIF (VCC)  $\overline{\text{STERM}} = \overline{\text{AS}} * \overline{\text{CS}} * \overline{\text{DA}} * \text{DB} * \overline{\text{CLK}} * \overline{\text{ADDW}}$ + AS \* CS \* DTACK \* DB \* CLK \* ADDW + EXST \* CLK + STERM \* CLK \*\*\* ''IF (CS) STERM'' could be used if the user desires to wire ''OR'' STERM outputs together from other peripherals.  $\overline{DA}$  =  $\overline{AREQ} * \overline{CS} * \overline{DTACK} * DB * \overline{ADDW}$  $\overline{\text{DB}}$ : =  $\overline{\text{AREQ}}$  \*  $\overline{\text{CS}}$  \*  $\overline{\text{DTACK}}$  \*  $\overline{\text{DA}}$  \* DB \*  $\overline{\text{ADDW}}$ + AREQ \* CS \* DTACK \* DB \* ADDW **KEY: READING PAL EQUATIONS WRITTEN IN PLAN** EXAMPLE EQUATIONS: IF (VCC)  $\overline{DC} = \overline{AS} * \overline{CS} * \overline{DB} * \overline{CLK}$ +  $\overline{AS}$  \*  $\overline{CS}$  \*  $\overline{DC}$  \* CLK This example reads: the output "DC" will transition low given that one of the following conditions are valid: 1. The input "AS" low AND the input "CS" is low AND the output "DB" is low and the input "CLK" is low, OR 2. The input "AS" is low AND the input "CS" is low AND the output "DC" is low and the input "CLK" is high.



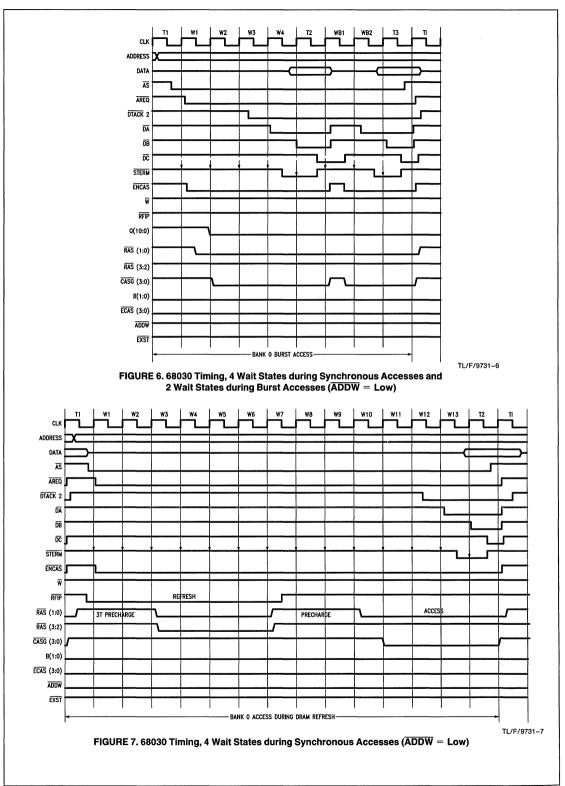
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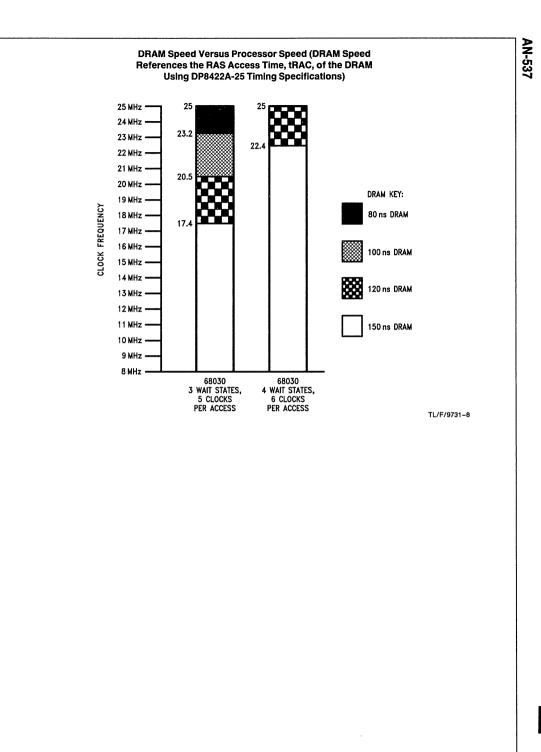
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4

# A PAL Interface for a Dual Access DP8422A/68030/ 74F632 Error Detecting and Correcting Memory System

### **I INTRODUCTION**

This application note describes a 3 PAL design that interfaces two 68030 microprocessors, both synchronous to the same system clock, to a DP8422A DRAM controller and a 74F632 Error Detection and Correction (EDAC) chip. It is assumed that the reader is already familiar with the 68030 CPU, the DP8422A DRAM controller, the 74F632 EDAC, and the basics of PAL design. The National Semiconductor DP8402A EDAC chip can be used in place of the 74F632 though it is a slower device.

This application note supports the following types of memory accesses:

- Read accesses with 6 wait states inserted (8 clock periods total in the synchronous mode read access), any single bit errors are automatically corrected before sending the data to the CPU (EDAC unit in always correct mode/ error monitoring mode is also described);
- Write accesses with 3 wait states inserted (5 clock periods total in the synchronous mode write access);
- Byte write accesses with 7 wait states inserted (9 clock periods total in the synchronous mode byte write access);
- Burst read accesses with 3 wait states in the burst portion of the access (4 clock periods total per synchronous mode burst read memory access);
- Scrubbing during DRAM refreshes (6 clock periods total during the refresh if no errors, 8 clock periods total during the refresh if any errors), any single bit errors are corrected. The corrected word is then written back to the DRAM.

### II DESCRIPTION OF 25 MHz DUAL ACCESS 68030 SYS-TEM INTERFACED TO THE DP8422A AND THE 74F632

This design allows two 68030 microprocessors to access a common error corrected dynamic memory system. The error corrected memory system is implemented using the 74F632 EDAC chip in the always correct mode. Whichever 68030 accessed the memory last has a higher priority. Both 68030s are interfaced to the DRAM in the synchronous mode of operation (the accesses are terminated with the 68030 STERM~ input). This allows the DRAM system to support burst mode accesses.

During read accesses the data is always processed through the EDAC chip (always correct type of system). If a single bit error occurs during a read access this design guarantees correct data to the CPU, but does not write the corrected data back to the DRAM. Single bit soft errors in memory are only corrected (written back to memory) during scrubbing type refreshes. The memory is scrubbed often enough that the probability of accumulating two soft errors in memory is very unlikely.

During read accesses the data is always processed through the 74F632 EDAC chip (i.e., the EDAC data buffers are enabled to provide the data to the CPU). The 74F632 is always put into latch and correct mode during read accesses, even though the data from the memory may be correct. This alNational Semiconductor Application Note 535



lows CAS  $\sim\,$  to be toggled early (before the CPU has sampled the data), during burst mode accesses, to start accessing the next word of the burst access.

This design drives two banks of DRAM, each bank being 39 bits in width (32 data bits plus 7 check bits) giving a maximum memory capacity of 32 Mbytes of error corrected memory (using 4 M-bit x 1 DRAMs). By choosing a different RAS ~ and CAS ~ configuration mode (see programming mode bits section of DP8422A data sheet) this application can support 4 banks of DRAM, giving a memory capacity of 64 Mbytes (using 4M-bit x 1 DRAMs, NOTE that when driving 64 Mbytes the timing calculations will have to be adjusted to the greater capacitive load).

The memory banks are interleaved on every four word (32bit word) boundary. This means that the address bit (A4) is tied to the bank select input of the DP8422A (B1).

Address bits A3,2 are tied to the highest row and column address inputs (R9, C9 for 1 Mbit DRAMs) to support burst accesses using nibble mode DRAMs. Nibble mode DRAMs must be used! The reason for this is that nibble mode DRAMs support address wrap-around during a burst access. Address wrap-around is needed during an internal cache miss where the 68030 starts a burst memory access on a non-page boundary (i.e., the first of a 4 word burst may have the least significant address bits, "A3,A2" = 10). Given this condition, the CPU expects word 2, word 3, word 0, word 1. On incrementing from word 3 to word 0 the address bit A4 must not change (the nibble page must remain the same). Nibble mode DRAMs support the address wraparound feature.

Address bits A1, A0 are used to produce the four byte select data strobes, used in byte reads and writes. If the majority of accesses made by the 68030 are sequential, the 68030 can be doing burst accesses most of the time. Each burst of four words can alternate memory banks (address bit A4 tied to DP8422A pin B1), allowing one memory bank to be precharging (RAS~ precharge) while the other bank is being accessed. This is a higher performance memory system than a non-interleaved memory system (bank select on the higher address bits). Each separate memory access to the same memory bank will generally require extra wait states to be inserted into the CPU access cycles to allow for the RAS~ precharge time.

The logic shown in this application note forms a complete 68030 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A. arbitration between Port A, Port B, and refreshing the DRAM;
- B. the insertion of wait states to the processor (Port A and Port B) when needed (i.e., if RAS ~ precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access . . . etc.);

C. performing byte writes and reads to the 32-bit words in memory:

D. normal and burst access operations.

By making use of the enable input on the 74AS244 buffer, this application allows dual access applications. The addresses and chip select are TRI-STATE® through this buffer, the write input (WIN~), lock input (LOCK~), and ECAS0-3 ~ inputs must also be able to be TRI-STATE (another 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B) the DP8422A allows dual accessing to be performed.

### **III ANOTHER OPTION FOR A 68030 25 MHz DUAL AC-**CESS EDAC DESIGN: THE EDAC ERROR MONITORING METHOD IN CONJUNCTION WITH THE 68030 ASYN-**CHRONOUS LATE RETRY FEATURE**

The 68030 dual access EDAC system design could use the error monitoring method in conjunction with the 68030 asynchronous late retry feature, instead of the always correct method (design shown in this application note). The error monitoring method can yield a slight improvement in system performance.

By using the error monitoring method of error correction single read accesses or the first read access during a burst access can be shortened by one clock period, allowing a synchronous read access to have only 5 wait states inserted, 7 clock periods total (compared to 6 wait states, 8 clock periods total when doing the always correct method). All other types of accesses (burst reads, byte writes, word writes, refresh scrubbing) will execute in the same number of clock cycles, and in the same manner as described in this application note.

Read accesses can save one wait state because the data from the DRAM memory is assumed to be correct in the error monitoring system design. Therefore the DRAM data is given directly to the CPU instead of running it through the EDAC chip as was done in the always correct method.

In order to do this design it is required that the asynchronous late retry feature of the 68030 and registered transceivers (74F646) be employed.

The asynchronous late retry feature of the 68030 involves pulling the 68030 input signals "BERR~ and HALT~" both low before the falling clock edge of the last clock cycle of the access. Given that this is done the 68030 will suspend all bus activity until HALT~ is brought high and then will retry the aborted bus cycle (unless that access is not currently needed by the CPU). This feature is useful for the case where an error is detected in the DRAM data. In this case BERR~ and HALT~ are brought low until the data from the DRAM is corrected (by the EDAC chip) and written back to the DRAM. BERR  $\sim$  and HALT  $\sim$  are then brough high to continue CPU processing.

Registered transceivers (74F646) are necessary during burst mode read accesses because CAS~ transitions high before the CPU has sampled the DRAM data. The registered transceivers hold the data valid until the CPU samples it during these cases.

A read, read with a single bit error, and burst read access timing are shown at the end of this application note implementing the error monitoring method. The user can see how these access cycles differ from the always correct method access cycles.

### IV 68030 25 MHz DUAL ACCESS DESIGN. PROGRAMMING MODE BITS

Programming Bits

### Description

- R0 = 1RAS~ low four clocks, RAS~ precharge of three clocks R1 = 1B2 = 1DTACK~ 1 is chosen. DTACK~ low first
- R3 = 0rising CLK edge after access RAS  $\sim$  is low.
- R4 = 0No WAIT states during burst accesses
- R5 = 0
- R6 = 0If WAITIN  $\sim = 0$ , add one clock to
  - DTACK~. WAITIN~ may be tied high or low in this application depending upon the number of wait states the user desires to insert into the access.
- R7 = 1Select DTACK~
- R8 = 1Non-interleaved mode R9 = X
- C0 = XSelect based upon the input "DELCLK" fre-
- C1 = X
  - quency. Example: if the input clock frequen-
  - C2 = Xcv is 20 MHz then choose C0.1.2 = 0.0.0(divide by ten, this will give a frequency of 2 MHz). If DELCLK of the DP8422A is over 20 MHz do an initial divide by two externally and then run that output into the DELCLK input and choose the correct divider.
  - C3 = XC4 = 0
    - RAS~ groups selected by "B1". This mode
  - C5 = 0 allows two RAS~ outputs to go low during C6 = 1 an access, and allows byte writing in 32-bit words.
  - C7 = 1Column address setup time of 0 ns
  - C8 = 1Row address hold time of 15 ns
  - C9 = 1Delay CAS~ during write accesses to one clock after RAS~ transitions low
  - B0 = 1Fall-thru latches
  - B1 = 1Access mode 1

ECAS0~ = 0 Non-extend CAS~

- 0 = Program with low voltage level
- 1 = Program with high voltage level
- X = Program with either high or low voltage level (don't care condition)

### V 68030 25 MHz WORST CASE TIMING CALCULATIONS

The worst case access is an access from Port B. This occurs because the time to  $RAS \sim and CAS \sim low is longer$  for the Port B access than; a Port A access, a refresh with scrubbing access, or an access which has been delayed from starting (due to refresh,  $RAS \sim$  precharge time, or the other Port accessing memory).

A. Worst case time to RAS  $\sim\,$  low from the beginning of an access cycle: '

40 ns (T1 clock period of 68030) + 10 ns (PAL16R4D maximum combinational output delay to produce AREQB $\sim$ ) + 41 ns (DP8422A-25 parameter #102, AREQ $\sim$  to RAS $\sim$  delay maximum) = 91 ns

B. Worst case time to CAS  $\sim\,$  low from the beginning of an access cycle:

40 ns + 10 ns + 94 ns (DP8422A-25 parameter #118a, AREQB $\sim$  to CAS $\sim$  delay maximum) = 144 ns

C. Worst case time to DRAM data valid:

144 ns (from "B" above, maximum time to CAS  $\sim$  ) + 50 ns (CAS  $\sim$  access time "t\_{CAC}" for a typical 100 ns DRAM) = 194 ns

- D. Worst case time to data valid on the EDAC data bus: 194 ns (from "C" above) + 7 ns (74AS244 maximum delay) = 201 ns
- E. Worst case time until the error flags are valid from the 74F632:

201 ns (from "D" above) + 31 ns (74F632 maximum time to error flags valid) = 232 ns

F. Worst case time until corrected data is valid from the 74F632:

201 ns (from "D" above) + 28 ns (74F632 maximum time from data in to corrected data out) = 229 ns

G. Worst case time until corrected data is available at the CPU:

229 ns (from "F" above) + 7 ns (74F245 maximum delay) = 236 ns

### VI 68030 25 MHz DUAL ACCESS DESIGN, TIMING CAL-CULATIONS

 Minimum ADS~ low setup time to CLOCK~ high for DTACK~ logic to work correctly (DP8422A-25 needs 25 ns, parameter #400b):

40 ns (one clock period) - 10 ns (PAL16R4D combinational output maximum that produces AREQ ~, ADS ~) = 30 ns

2a. Minimum address setup time to ADS ~ low (DP8422A-25 needs 14 ns, parameter #404):

40 ns (one clock period) -20 ns (assumed 68030 max time to address valid from CLK high) -6.2 ns (74AS244 buffer delay max) +2.5 ns (minimum PAL 16R4D combinational output delay that produces AREQ~, ADS~) = 16.3 ns

2b. Minimum address setup time to CLK high (used in #3B calculation below):

40 ns (one clock period) -20 ns (assumed 68030 max time to address valid from CLK high) -6.2 ns (74AS244 buffer delay max) = 13.8 ns

3a. Minimum CS~ setup time to ADS~ low (DP8422A-25 needs 5 ns, parameter #401):

16.3 ns (#2a) - 9 ns (max 74AS138 decoder) = 7.3 ns

3b. Minimum CS  $\sim\,$  setup time to CLK high (PAL equations need 0 ns):

13.8 ns (#2b) - 9 ns (max 74AS138 decoder) = 4.8 ns

Determining t<sub>RAC</sub> during a normal access (RAS ~ access time needed by the DRAM):

200 ns (five and one-half clock periods to get data from the DRAM to the 74F632 data inputs) -3 ns (74F632 data setup time to mode input S0 high) +2.5 ns (minimum PAL16R4D combinational output delay for "S0") -84 ns (from "A" of worst case times, from the beginning of the access to RAS~ low) -6.2 ns (74F244 DRAM buffer delay maximum) = 129.3 ns

Therefore the  $\ensuremath{t_{\text{RAC}}}$  of the DRAM must be 129.3 ns or less.

5. Determining  $t_{CAC}$  during a normal access (CAS  $\sim$  access time) and column address access time needed by the DRAM:

220 ns (five and one-half clock periods to get data from the DRAM to the 74F632 data inputs) -3 ns (74F632 data setup time to mode input S0 high) +2.5 ns (minimum PAL16R4D combinational output delay for "S0") -138 ns (from "B" of worst case times, from the beginning of the access to CAS~ low) -6.2 ns (74F244 DRAM buffer delay maximum) =75.3 ns

Therefore the  $t_{\mbox{CAC}}$  of the DRAM must be 75.3 ns or less.

Determining the nibble mode access time needed during a burst access:

100 ns (two and one-half clock periods to do the burst) - 8 ns (PAL16R4D clocked output delay maximum for ENCAS~ output) - 27 ns (DP8422A-25 ECASn~ to CASn~ asserted maximum, parameter #14) - 3 ns (74F632 data setup time to mode input S0 high) + 2.5ns (minimum PAL16R4D combinational output delay for "S0") - 6.2 ns (74F244 DRAM buffer delay maximum) = 58.3 ns

Therefore the nibble mode access time of the DRAM must be 58.3 ns or less

 Maximum time to DTACK1 ~ Iow (PAL16R4D needs 10 ns setup to CLK):

40 ns (One clock) - 28 ns (DTACK2 $\sim$  low from CLK high on DP8422A-25, parameter #18) = 12 ns

 Minimum STERM ~ setup time to CLK (0 ns to CLK rising edge is needed by the 68030):

20 ns (one-half clock period) - 10 ns (PAL16R4D combinational output maximum) = 10 ns

\*\*Note: That calculations can be performed for different frequencies and/or different combinations of wait states by substituting the appropriate values into the above equations.

| VII PAL INPU | TDESCRIPTIONS                                                                                                                                                                                                                                        |
|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| BCLK         | System Clock                                                                                                                                                                                                                                         |
| CLK          | System Clock                                                                                                                                                                                                                                         |
| CSA~         | Chip Select from Port A 68030                                                                                                                                                                                                                        |
| ASA~         | Address Strobe from Port A 68030                                                                                                                                                                                                                     |
| CSASA~       |                                                                                                                                                                                                                                                      |
| 05A5A~       | Chip selected access request from Port A 68030                                                                                                                                                                                                       |
| CSB~         | Chip Select from Port B 68030                                                                                                                                                                                                                        |
| ASB~         | Address Strobe from Port B 68030                                                                                                                                                                                                                     |
| DTACK~       | Data Transfer ACKnowledge for Port B accesses                                                                                                                                                                                                        |
| ATACKB~      | Transfer ACKnowledge for Port B accesses                                                                                                                                                                                                             |
| R            | Read/Write~ (R/W~) indicator from the currently granted CPU                                                                                                                                                                                          |
| CBREQ~       | Cache Burst REQuest indicator from the cur-<br>rently granted CPU                                                                                                                                                                                    |
| WCBREQ~      | When low this signal indicates either a write access or a non-burst access                                                                                                                                                                           |
| RFIP~        | Indicates that a DRAM refresh is in progress                                                                                                                                                                                                         |
| RAS0~        | RAS0~ output from the DP8422A DRAM controller                                                                                                                                                                                                        |
| WORD~        | Indicates a word access (32 bits) as opposed<br>to a byte or multi-byte access (less than 32<br>bits)                                                                                                                                                |
| GRANTB       | GRANTB output from the DP8422A DRAM<br>controller, when high this output indicates<br>that Port B currently is granted to access the<br>DRAM                                                                                                         |
| VIII PAL OUT | PUT DESCRIPTIONS                                                                                                                                                                                                                                     |
| AREQ~        | DRAM Access REQuest for Port A 68030                                                                                                                                                                                                                 |
| AREQB~       | DRAM Access REQuest for Port A 68030                                                                                                                                                                                                                 |
| COUNT~       | The enable for the shift register counter (outputs $D1-6\sim$ )                                                                                                                                                                                      |
| D1-6~        | Shift register counter, these outputs are used<br>to drive the PAL control outputs in the proper<br>sequence for each access (Port A, Port B,<br>refresh) and are clocked outputs                                                                    |
| ENCAS~       | This output, when low, enables the CAS~<br>outputs of the DP8422A DRAM controller<br>and is a clocked output                                                                                                                                         |
| EXRF~        | This output is used to EXtend the ReFresh<br>cycle to allow an access from one of the<br>banks of DRAM, if an error occurs (ERR ~<br>low) the refresh cycle is extended even long-<br>er to allow the corrected data to be written<br>back to memory |
| S0~          | This output controls the S0 mode input of the 74F632                                                                                                                                                                                                 |
| S1~          | This output controls the S1 mode input of the 74F632                                                                                                                                                                                                 |
| TRAN_EN~     | This output is used to enable the data trans-<br>ceivers for the currently enabled Port (A or B)                                                                                                                                                     |
| OEB~         | This output is used to drive the OEB0-3 $\sim$ inputs of the 74F632 to provide byte output control of the latched corrected data                                                                                                                     |
| OECB~        | This output controls when to enable the check bits out of the 74F632                                                                                                                                                                                 |
| LEDB0~       | This output is used to latch the corrected data in the output latches of the 74F632                                                                                                                                                                  |
| <br>         |                                                                                                                                                                                                                                                      |

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| STERMA~ | This output is used to insert synchronous wait states to the Port A 68030                           |
|---------|-----------------------------------------------------------------------------------------------------|
| STERMB~ | This output is used to insert synchronous wait states to the Port B 68030                           |
| SERR~   | This output latches the fact that the 74F632 detected an error in the data it read from the DRAM    |
| BERR~   | This output latches that the 74F632 detected a multiple bit error in the data it read from the DRAM |
| WE~     | This output controls write enable to the DRAMs                                                      |
|         |                                                                                                     |

# IX 68030 25 MHz DUAL ACCESS EDAC SYSTEM DESIGN PAL EQUATIONS IN ABEL FORMAT

DP1 device "PAL16R4D"

| BCLK    | pin 1;  | VCC    | pin 20; |
|---------|---------|--------|---------|
| CLK     | pin 2;  | AREQ~  | pin 19; |
| CSASA~  | pin 3;  | AREQB~ | pin 18; |
| CSB~    | pin 4;  | D1~    | pin 17; |
| ASB~    | pin 5;  | D2~    | pin 16; |
| DTACK~  | pin 6;  | D3~    | pin 15; |
| ATACKB~ | pin 7;  | ENCAS~ | pin 14; |
| WCBREQ~ | pin 8;  | COUNT~ | pin 13; |
| RFIP~   | pin 9;  | RAS0~  | pin 12; |
| GND     | pin 10; | OE~    | pin 11; |

### EQUATIONS

!AREQ~ = ICSASA~ & CLK # !AREQ~ & ICSASA~ # !AREQ~ & ICLK;

- IAREQB∼ = ICSB∼ & IASB∼ & CLK #IAREQB∼ & ICSB∼ & IASB∼ #IAREQB∼ & ICLK;
- ICOUNT∼ = IAREQ∼ & IDTACK∼ & ICSASA∼ #IAREQB∼ & IATACKB∼ & IASB∼ #IRFIP∼ & IRAS0∼;
- !D1 ~ := !AREQ ~ & !DTACK ~ #!ATACKB ~ & !AREQB ~ #!RFIP ~ & !RAS0;
- !D2~ :!D1~ & D3~ & !COUNT~ #D3~ & !AREQ~ & !DTACK~ & RFIP~;

 $|D3 \sim := |D2 \sim \& |COUNT \sim;$ 

!ENCAS~ := !WCBREQ~

- # D1∼ # !D2∼ # D3∼
- # !RFIP~;

### DP2 device "PAL16L8D"

| BCLK   | pin 1;  | VCC      | pin 20; |
|--------|---------|----------|---------|
| R      | pin 2;  | EXRF~    | pin 19; |
| WORD~  | pin 3;  | S0       | pin 18; |
| GRANTB | pin 4;  | S1       | pin 17; |
| RFIP~  | pin 5;  | TRAN_EN~ | pin 16; |
| SERR~  | pin 6;  | OEB~     | pin 15; |
| D2~    | pin 7;  | OECB~    | pin 14; |
| D5~    | pin 8;  | STERMA~  | pin 13; |
| D6~    | pin 9;  | STERMB~  | pin 12; |
| GND    | pin 10; | OE~      | pin 11; |

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```
EQUATIONS
!EXRF~ = !RFIP~ & S1 & !D2~ & D5~ & D6~ &
         SERR~
     #IEXBE~ & IBEIP~ & S1 & D5~ & D6~
     #!RFIP~ & !D5~ & !SERR~:
1S0 = 1R & 1WORD~ & RFIP~
     # !D2~ & D5~
     # !S0 & BCLK
     # !D5~ & !BCLK
     # !S0 & !D5~
     # IS0~ &! D6~
     # !S1 & !SERR~ & !RFIP~;
IS1 = IR & IWORD~ & REIP~
     # 1D5~ & 1BCLK
     # IS1 & ID5~
     # !S1 & !D6~ & !R & WORD~
     # !S1 & !D6~ & !RFIP~
     # IS1 & ISERR~ & IRFIP~:
!TRAN\_EN \sim = R \& !D5 \sim \& !BCLK \& RFIP \sim
     # !TRAN_EN~ & R & !D5~ & D6~ & RFIP~
     # R & !D5~ & !STERMA~ & RFIP~
     # R & ID5~ & ISTERMB~ & RFIP~
     # IR & !WORD~ & !S1 & RFIP~
     # !R & WORD~ & !D5~ & !BCLK & RFIP~
     # !TRAN_EN~ & !R & WORD~ & !D5~ &
       RFIP~
     # !TRAN_EN~ & !R & WORD~ & !D6~ &
       RFIP~;
|OEB \sim = R \& |D5 \sim \& |BCLK|
    # !OEB~ & R & !D5~
    # !RFIP~ & !D5~ & !BCLK & !SERR~
    # !OEB~ & !RFIP~ & !D5~ & !SERR~
    # !OEB~ & !RFIP~ & !D6~ & !SERR~
    # !R & WORD~ & !D5~ & !BCLK
    # !OEB~ & !R & WORD~ & !D5~
    # !OEB~ & !R & WORD~ & !D6~;
!OECB~ = !R & !WORD~ & RFIP~ & !S1
    # !RFIP~ & !D5~ & !BCLK & !SERR~
    # !OECB~ & !RFIP~ & !D5~ & !SERR~
    # !OECB~ & !RFIP~ & !D6~ & !SERR~
    # !R & WORD~ & !D5~ & !BCLK
    # !OECB~ & !R & WORD~ & !D5~
    # !OECB~ & !R & WORD~ & !D6~;
|STERMA \sim = R \& RFIP \sim \& |D5 \sim \& D6 \sim \&
            !GRANTB~ & !BCLK
     # !STERMA~ & R & RFIP~ & !D5~ &
      !GRANTB~ & BCLK
     # !R & !WORD~ & RFIP~ & !D2~ & D6~ &
      !GRANTB~ & !BCLK
     # !STERMA~ & !R & !WORD~ & RFIP~ &
      1D2~ & D6~ IGRANTB & BCLK
     # !R & WORD~ & RFIP~ & !D5~ & !D6~ &
       IGRANTB~ & IBCLK
     # !STERMA~ & !R & WORD~ & RFIP~ & !D6 &
       IGRANTB & BCLK:
```

ISTERMB~ = R & RFIP~ & ID5~ & D6~ & GRANTB~ & IBCLK # ISTERMB~ & R & RFIP~ & ID5~ & GRANTB~ & BCLK # IR & IWORD~ & RFIP~ & ID2~ & D6~ & IGRANTB & IBCLK # ISTERMB~ & IR & IWORD~ & RFIP~ & ID2~ & D6~ GRANTB & BCLK

- # !R & WORD~ & RFIP~ & !D5~ & !D6~ & GRANTB~ & !BCLK
- # ISTERMB~ & IR & WORD~ & RFIP~ & ID6 & GRANTB & BCLK;

### DP3 device "PAL16R4D"

| BCLK   | pin 1;  | VCC    | pin 20; |
|--------|---------|--------|---------|
| CLK    | pin 2;  | LEDB0~ | pin 19; |
| S0~    | pin 3;  | SERR~  | pin 18; |
| S1~    | pin 4;  | WE~    | pin 17; |
| ERR~   | pin 5;  | D4~    | pin 16; |
| MERR~  | pin 6;  | D5~    | pin 15; |
| COUNT~ | pin 7;  | D6~    | pin 14; |
| D2~    | pin 8;  | BERR~  | pin 13; |
| D3~    | pin 9;  | OECB~  | pin 12; |
| GND    | pin 10; | OE~    | pin 11; |

### EQUATIONS

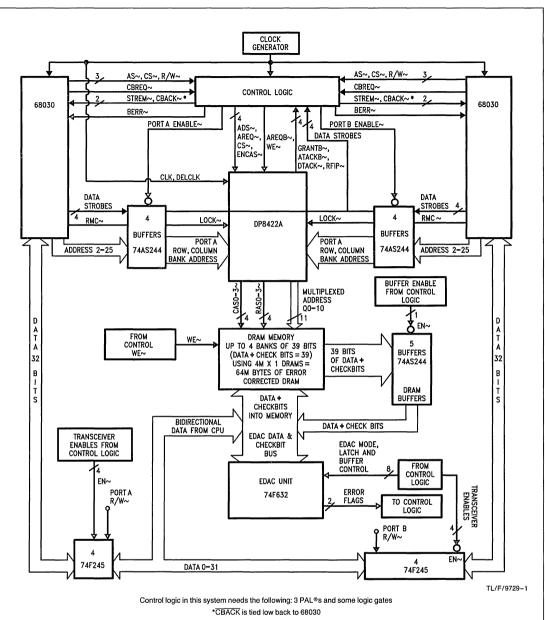
- ILEDB0 = ID2~ & IS0~ & S1~ & ICLK #ILEDB0~ & ID3~ & IS0~ #ILEDB0~ & ICLK
- ISERR~ = ID4~ & S0~ & S1~ & ICOUNT~ & IERR~ & CLK #ISERR~ & ICOUNT~:
- !BERR~ = D4~ & S0~ & S1~ & !COUNT~ & !MERR~ & CLK #!BERR~ & !COUNT~;
- !WE~ := !S1~ & !D2~ & D3~ & !COUNT~ & !OECB~:
- $|D4 \sim := |D3 \sim \& |COUNT \sim :$
- $!D5 \sim := !D4 \sim \& !COUNT \sim :$
- $!D6 \sim := !D5 \sim \& !COUNT \sim :$

### **Key: Reading PAL equations**

- EXAMPLE EQUATIONS:
- IAREQ~ = ICSASA~ & CLK # IAREQ~ & ICSASA~
  - # !AREQ~ & !CLK~

This example reads: the output "AREQ $\sim$ " will transition low given that one of the following conditions are valid;

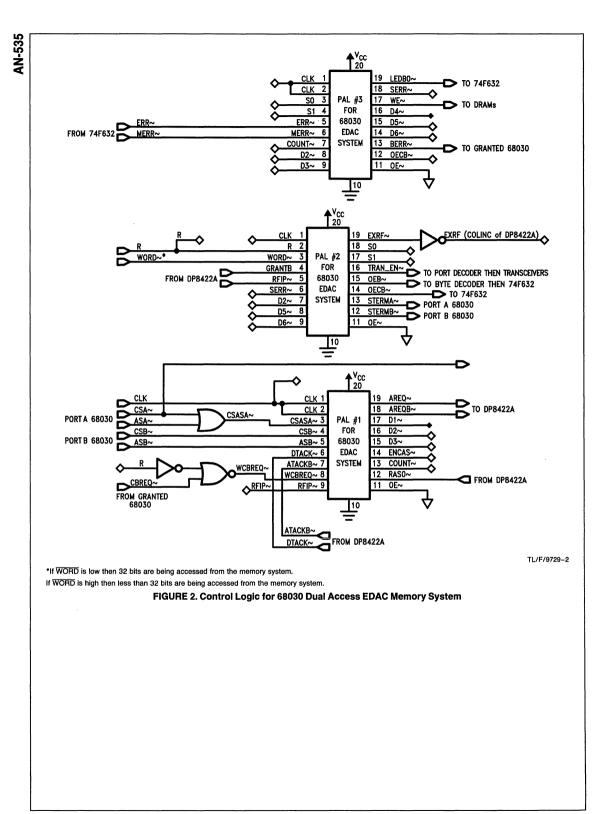
- 1. the input "CSASA  $\sim$  " is low AND the input "CLK" is high, OR
- 2. the output "AREQ ~ " is low AND the input "CSASA ~ " is low, OR
- 3. the output "AREQ  $\sim$  " is low AND the input "CLK" is low.

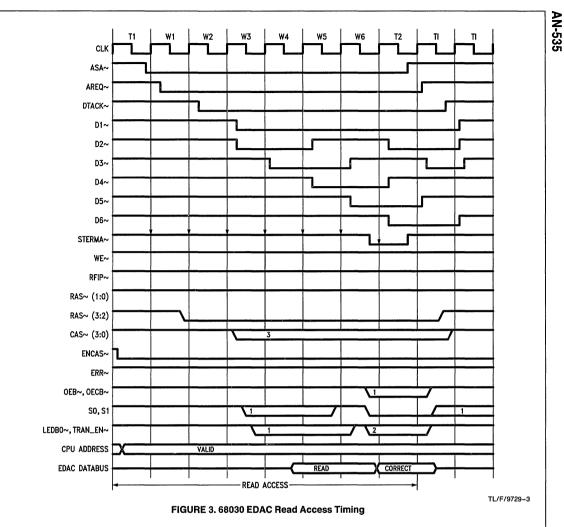




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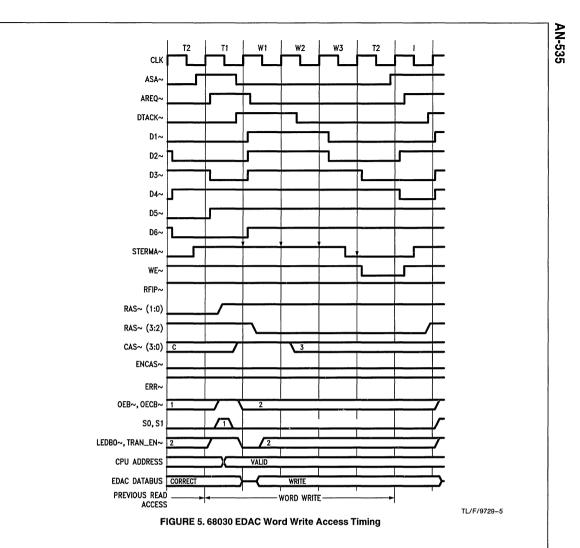




T2 BW1 ₩1 W2 ₩3 ₩5 W6 BW2 BW3 T3 BW1 BW2 BW3 T4 BW1 BW2 T1 W4 BW3 T5 CLK ASA~ AREQ~ DTACK~ D1~ D2~ D3~ D4~ D5~ D6~ STERMA~ WE~ RFIP~ RAS~ (1:0) RAS~ (3:2) CAS~ (3:0) ) C С C C C ENCAS~ ERR~ OEB~, OECB~ 📘 111 S0, S1  $\int_{1}$ 1 /Τ 1 LEDBO~,  $\sqrt{1}$ 1 2 1 2 . 2 12 TRAN\_EN~ CPU ADDRESS VALID CORRECT 3 CORRECT 4 EDAC DATABUS CORRECT CORRECT 1 CORRECT 2 READ 3 READ 4 READ 1 READ 2 Previous Read Access -BURST READ ACCESS-TL/F/9729-4 FIGURE 4. 68030 EDAC Burst Read Access Timing

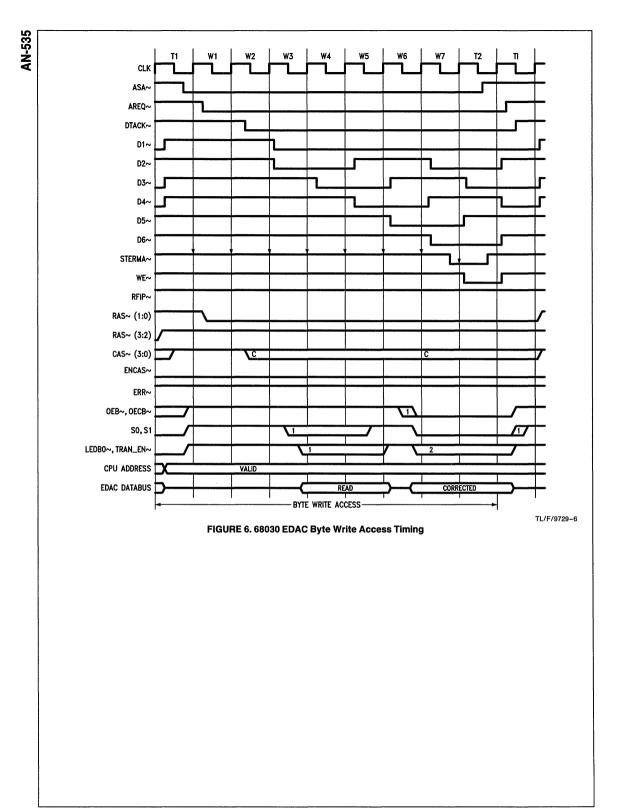
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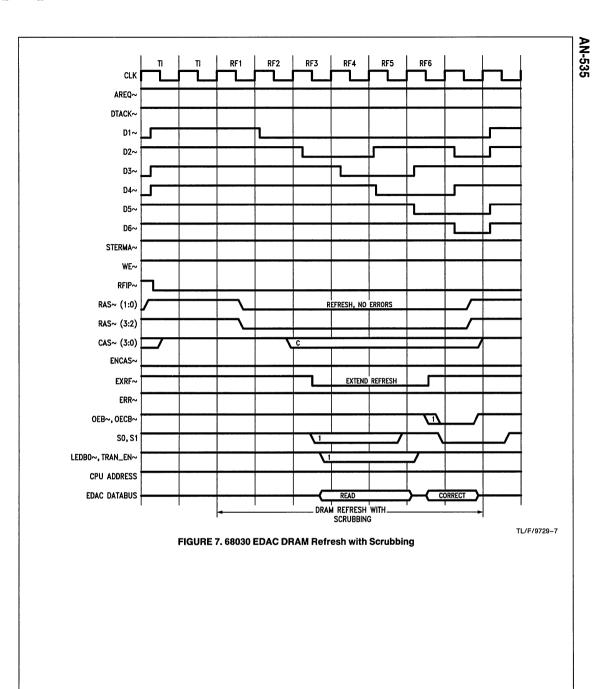
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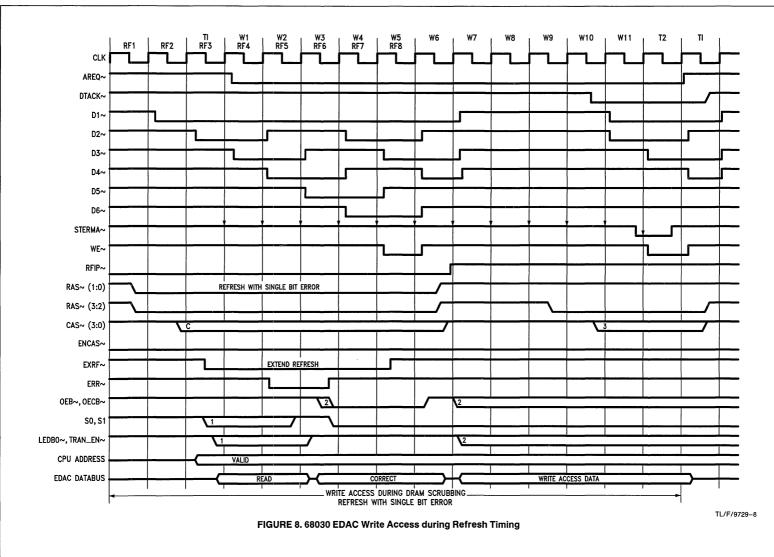


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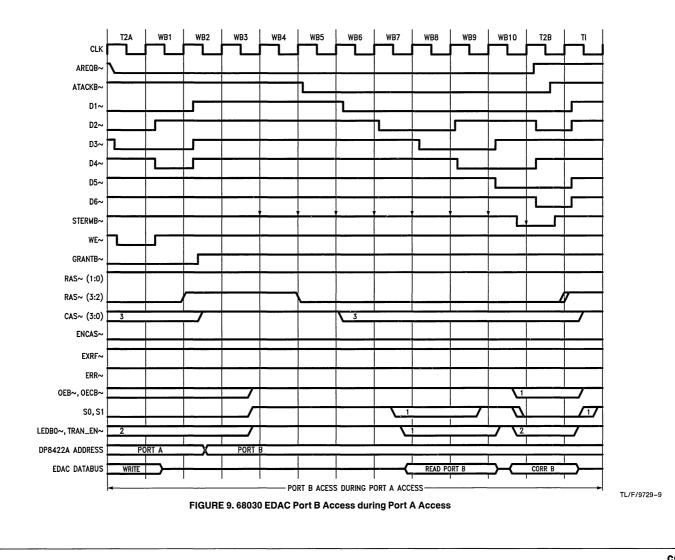




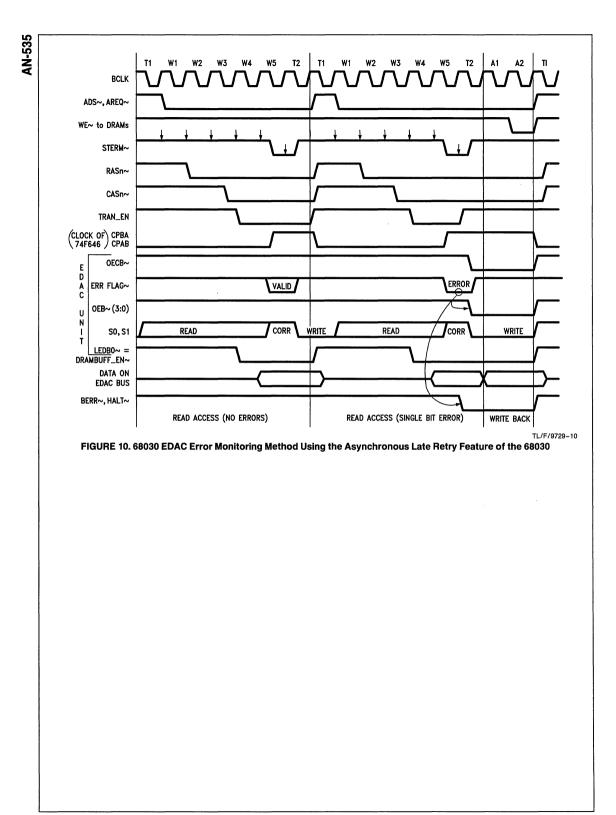


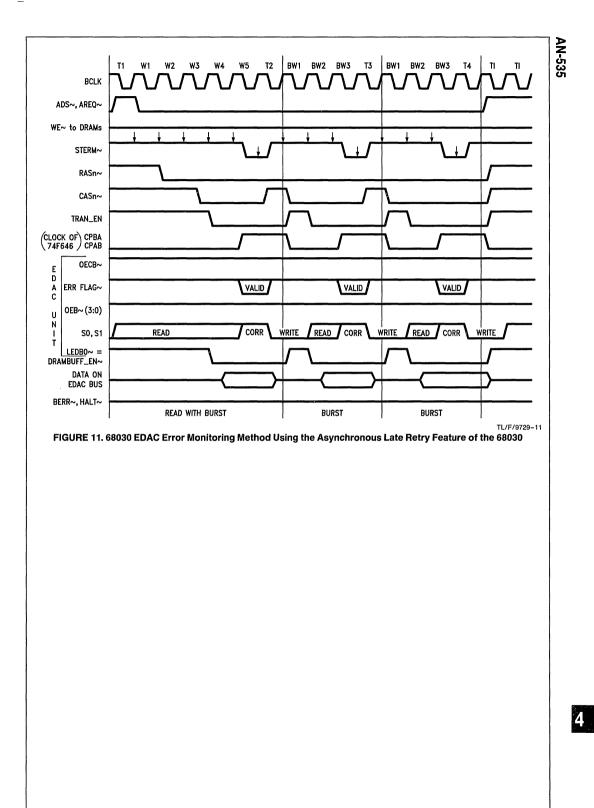
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# Interfacing the DP8420A/ 21A/22A to the 8086/186/ 88/188 Microprocessor

### I INTRODUCTION

This application note describes how to interface the 80186 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). It is assumed that the reader is already familiar with 80186 and the DP8422A modes of operation. This application note will also allow the 8086/88/ 188 to interface to the DP8420A/21A/22A.

### II DESCRIPTION OF DESIGN, 8086/88/186/188 OPERATING AT UP TO 16 MHz (UP TO 12.5 MHz WITH 0 WAIT STATES)

The block diagram of this design is shown driving four banks of DRAM, each bank being 16 bits in width, giving a maximum memory capacity of up to 32 Mbytes (using 4 M-bit  $\times$  1 DRAMs).

The memory banks are interleaved on word (16-bit word) boundries. This means that the address bits (A1,2) is tied to the bank select inputs of the DP8422A (B0,1).

Address bit A0 is used, along with Bus High Enable ( $\overline{BHE}$ ), to produce the two byte select data strobes. These byte selects (A0,  $\overline{BHE}$ ) are used in byte reads and writes as well as selects for the transceivers.

This application allows 0 or more wait states to be inserted in normal accesses of the 8086/186/88/188. The number of wait states can be adjusted through the WAITIN input of the DP8422A.

The logic shown in this application note forms a complete 8086/186/88/188 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A. arbitration between Port A, Port B and refreshing the DRAM;
- B. the insertion of wait states to the processor (Port A and Port B) when needed (i.e., if RAS precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access . . . etc);
- C. performing byte writes and reads to the 16-bit words in memory.

If the system uses the 8086/88 the "ALE" output can be directly input to the DP8420A/21A/22A, the 74AS08 "AND" gate and the two 74AS04 inverters on the "ALE" output are not needed.

By using the "output control" pins of some external latches (74AS373's), this application can easily be used in a dual access application. The addresses could be tri-stated through these latches, the write input ( $\overline{WIN}$ ), lock input ( $\overline{LOCK}$ ), and  $\overline{ECAS0-3}$  inputs must also be able to be tri-stated (a 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B) the DP8422A can be used in a dual access application. If this design is used in a dual acc

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cess application the  $t_{RAC}$  and  $t_{CAC}$  (required  $\overline{RAS}$  and  $\overline{CAS}$  access time required by the DRAM) will have to be recalculated since the time to  $\overline{RAS}$  and  $\overline{CAS}$  is longer for the dual access application (see TIMING section of this application note).

### III 8086/186/88/188 DESIGN, 10 MHz WITH 0 WAIT STATES DURING NORMAL ACCESSES, PROGRAM MODE BITS

| Programming<br>Bits    | Description                                                        |
|------------------------|--------------------------------------------------------------------|
| R0 = 0                 | RAS low two clocks, RAS precharge                                  |
| R1 = 1                 | of two clocks. If more                                             |
|                        | RAS precharge is desired the user                                  |
|                        | should program three periods of RAS                                |
|                        | precharge.                                                         |
| R2 = 0<br>R3 = 0       | WAIT zero is chosen. WAIT follows                                  |
| R3 = 0<br>R4 = 0       | the access RAS low.                                                |
| R4 = 0<br>R5 = 0       | No WAIT states during burst accesses                               |
| R6 = 0                 | If $\overline{WAIT} = 0$ , add one clock to $\overline{WAIT}$ .    |
|                        | WAITIN may be tied high or low in this                             |
|                        | application depending upon the                                     |
|                        | number of wait states the user desires                             |
|                        | to insert into the access                                          |
| R7 = 0                 | Select WAIT                                                        |
| R8 = 1                 | Non-interleaved Mode                                               |
| R9 = X                 |                                                                    |
| C0 = X<br>C1 = X       | Select based upon the input<br>"DELCLK" frequency. Example: if the |
| $C_2 = X$              | input clock frequency is 10 MHz then                               |
|                        | choose $C0,1,2 = 1,0,1$                                            |
|                        | (divide by five, this will give a                                  |
|                        | frequency of 2 MHz).                                               |
| C3 = X                 | 4 J ,                                                              |
| C4 = 0                 | RAS banks selected by "B0,1". This                                 |
| C5 = 1                 | mode allows one RAS                                                |
| C6 = 1                 | output to go low during an access, and                             |
|                        | allows byte writing in                                             |
| C7 = 1                 | 16-bit words.<br>Column address setup time of 0 ns.                |
| $C_7 = 1$<br>$C_8 = 1$ | Row address hold time of 15 ns                                     |
| C9 = 1                 | Delay CAS during write accesses to                                 |
|                        | one clock after RAS transitions low                                |
| B0 = 1                 | Fall through latches.                                              |
| B1 = 0                 | Access mode 0                                                      |
| ECAS0 = 0              | CAS not extended beyond RAS                                        |

0 = Program with low voltage level

1 = Program with high voltage level

X = Program with either high or low voltage level (don't care condition)

#### IV 8086/186/88/188 TIMING CALCULATIONS FOR DESIGN AT 10 MHz WITH NO WAIT STATES DURING NORMAL ACCESSES

1. Minimum ALE high setup time to CLOCK high (DP8422A-20 needs 16 ns, #301a):

100 ns (one clock period) - 9 ns (maximum delay through two 74AS04S) - 6 ns (74AS08 max delay) = 85 ns

2. Minimum address setup time to CLK high (DP8422A-20 needs 20 ns, #303):

100 ns (one clock period) - 50 ns (min address valid delay, TCLAV parameter in 80C186 data sheet) - 6 ns (74AS373 max delay) + 1 ns (74ALS04B min delay) = 45 ns

3. Minimum CS setup time to clock high (DP8422-20 needs 14 ns, #300):

45 ns (#2 above) - 10 ns (max 74ALS138 decoder) = 35 ns

4. Determining  $t_{RAC}$  during a normal access (RAS access time needed by the DRAM):

200 ns (two clock periods to do the access) -32 ns (CLK to RAS low max, DP8422-20 #307) -15 ns (8086/186/88/188 data setup time, TDVCL) -8 ns (74AS245A max delay) -5 ns (74AS04 max delay, clock skew) = 140 ns

Therefore the  $t_{\mbox{\scriptsize RAC}}$  of the DRAM must be 140 ns or less.

5. Determining  $t_{CAC}$  during a normal access (CAS access time) and column address access time needed by the DRAM:

200 ns - 89 ns (CLK to CAS low on DP8422A-20, #308a) - 15 ns - 8 ns - 5 ns = 83 ns

Therefore the t<sub>CAC</sub> of the DRAM must be 83 ns or less.

 Minimum SRDY (Synchronous ReaDY) setup time to SYSCLK low (CLK to DP8422A is inverted from SYSCLK), 8086/186/88/188 SRDY input needs 15 ns, TSRYCL:

100 ns (one clock period) - 39 ns (DP8422A-20 max delay to  $\overline{\text{WAIT}}$  0 high after arbitration, parameter #17) = 61 ns

Note: Calculations can be performed for different frequencies, different logic (ALS or CMOS . . . etc), or the DP8422A-25, and/or different combinations of wait states by substatuting the appropriate values into the above equations.

### V 8086/186/88/188 TIMING CALCULATIONS FOR DESIGN AT 16 MHz WITH ONE WAIT STATE DURING NORMAL ACCESSES (THE WAITIN INPUT OF THE DP8422A SHOULD BE TIED LOW)

1. Minimum ALE high setup time to CLOCK high (DP8422A-20 needs 16 ns, #301a):

62.5 ns (one clock period) - 9 ns (maximum delay through two 74AS04s) - 6 ns (74AS08 max delay) = 47.5 ns

2. Minimum address setup time to CLK high (DP8422A-20 needs 20 ns, #303):

62.5 ns (one clock period) - 33 ns (min address valid delay, TCLAV parameter in 80C186 data sheet) - 6 ns (74AS373 max delay) + 1 ns (74ALS04B min delay) = 24.5 ns

3. Minimum CS setup time to clock high (DP8422A-20 needs 14 ns, #300):

24.5 ns (#2 above) - 10 ns (max 74ALS138 decoder) = 14.5 ns

 Determining t<sub>RAC</sub> during a normal access (RAS access time needed by the DRAM):

182.5 ns (three clock periods to do the access) - 32 ns (CLK to  $\overline{RAS}$  low max, DP8422A-20 #307) - 15 ns (8086/186/88/188 data setup time, TDVCL) - 8 ns (74S245A max delay) - 5 ns (74AS04 max delay, clock skew) = 122.5 ns

Therefore the  $t_{\mbox{\scriptsize RAC}}$  of the DRAM must be 122.5 ns or less.

 Determining t<sub>CAC</sub> during a normal access (CAS access time) and column address access time needed by the DRAM:

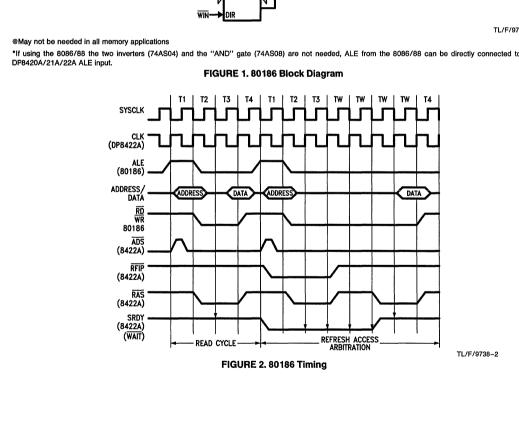
182.5 ns - 89 ns (CLK to  $\overline{CAS}$  low on DP8422A-20, #308a) - 15 ns - 8 ns - 5 ns = 65.6 ns

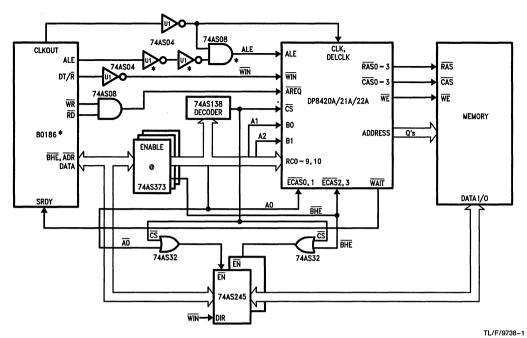
Therefore the  $t_{\mbox{CAC}}$  of the DRAM must be 65.5 ns or less.

 Minimum SRDY (Synchronous ReaDY) setup time to SYSCLK low (CLK to DP8422A is inverted from SYSCLK), 8086/186/88/188 SRDY input needs 15 ns, TSRYCL:

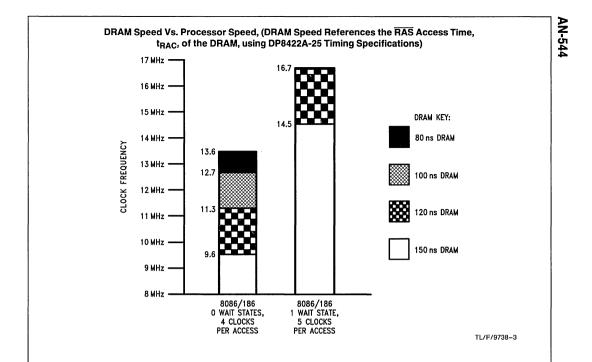
62.5 ns (one clock period) - 39 ns (DP8422A-20 max delay to WAIT 1 high, parameter #17) = 23.5 ns

Note: Calculations can be performed for different frequencies, different logic (ALS or CMOS ... etc), the DP8422A-25 and/or different combinations of wait states by substatuting the appropriate values into the above equations.





\*If using the 8086/88 the two inverters (74AS04) and the "AND" gate (74AS08) are not needed, ALE from the 8086/88 can be directly connected to the



### Interfacing the DP8420A/21A/22A to the 80286

### INTRODUCTION

This application note describes how to interface the 80286 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). There are three designs contained within this application note. The designs differ in terms of the maximum allowable frequency of operation. Design #1 can be used up to 16 MHz (80286-8) with one wait state. Design #2 can be used up to 20 MHz (80286-10) with one wait state. Design #3 can be used up to 25 MHz (80286-12) with one wait state. It is assumed that the reader is already familiar with 80286 access cycles and the DP8422A modes of operation.

### DESCRIPTION OF DESIGN # 1, ALLOWS UP TO 16 MHz OPERATION (CLOCK OUTPUT OF THE 82284) WITH NO WAIT STATES USING THE 80286-8

Design #1 (see *Figures 1 and 2*) consists of the DP8422A DRAM controller and several logic gates. These parts interface to the 80286 as shown in the block diagram. It accommodates two banks of DRAM, each bank being 16 bits in width, giving a maximum memory capacity of 16 Mbytes (using 4M-bit X 1 DRAMs). By choosing a different RAS and CAS configuration mode (see programming mode bits section of 8422A data sheet) this application could support 4 banks of DRAM, giving a memory capacity of 32 Mbytes (using 4M-bit X 1 DRAMs).

The memory banks are interleaved. This means that the least significant address bit (A1) is tied to the bank select input of the DP8422A (B1). Because the majority of accesses made by the 80286 will be sequential in nature, one memory bank can be precharging ( $\overline{RAS}$  precharge) while the other bank is being accessed. The interleaved memory system has higher system performance than a non-interleaved memory system, each sequential access will generally be to the same memory bank thereby requiring extra wait states to be inserted into the CPU access cycles to allow for the  $\overline{RAS}$  precharge time.

The user can choose non-address pipelined mode for this design as long as the parameter "AREQ negated to CLK high minimum to guarantee tASR = 0 ns" is guaranteed (45 ns minimum for the 8422A-20, 39 ns for the 8422A-25). At 16 MHz, the user must choose address pipelined mode since it is not possible to meet the above parameter (62.5 ns one clock - 25 ns MRDC,MWRC max valid - 5.5 ns 74AS08 max delay + 1 ns min 74AS00 CLOCK delay = 33.5 ns which is less than the 39 ns the DP8422A-25 needs). When using the DP8422A in address pipelined mode, the DR4Ms chosen should need a minimum column address hold time of 32 ns or less.

The logic shown in this application note forms a complete 80286 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

A. Arbitration between Port A, Port B, and refreshing the DRAM;

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- B. The insertion of wait states to the processor (Port A and Port B) when needed (i.e., if RAS precharge is needed, refresh is occurring during a memory access, the other Port is currently doing an access ... etc.);
- C. Performing byte writes and reads to the 16-bit words in memory.

Since the  $\overline{\text{WE}}$  output of the DP8422A becomes refresh request (RFRQ) if the chip is programmed in address pipelining mode, the  $\overline{\text{WIN}}$  signal was buffered to provide  $\overline{\text{WE}}$  to the DRAMs.

The gates labeled "U1" should both be in the same package (74AS00) so that their delays cancel, see the TIMING section for how these delays cancel.

The ready logic can be made faster by programming DTACK0 into the DP8422A and running this through a fast bipolar flip-flop clocked by CLOCK.

By making use of the enable input on the 74AS373 latch, this application can easily be used in a dual access application. The addresses and chip select are TRI-STATE® through this latch, the write input (WIN), lock input (LOCK), and ECASO-3 inputs must also be able to be TRI-STATE a 74AS244 could be used for this purpose). By multiplexing the above inputs, (through the use of the above parts and similar parts for Port B) the DP8422A can be used in a dual access application. All the timing (see TIMING section of this application note) will remain the same whether single or dual accessing is implemented.

### DESCRIPTION OF DESIGN #2, ALLOWS UP TO 20 MHz OPERATION (CLOCK OUTPUT OF THE 82284) WITH NO WAIT STATES USING THE 80286-10

Design #2 (see *Figures 3, 4, 5*) is basically the same as Design #1 except for the following changes:

- A. The circuit that produces SRDY, the gate signal for the 74AS373 transparent latches, and AREQ has been changed to using DTACK0, several 74AS374 flip-flops, and some logic gates. This was needed for speed in producing the gating signal of the 74AS373 (so as to get adequate address and chip select setup time),
- B. The output "D1" which is used to produce the AREQ input was gated with CS. This was done to guarantee that the DTACK2 output becomes defined after power up,
- C. This design will work at 20 MHz,
- D. This design has zero wait states inserted in normal sequential accesses, multiple wait states may be inserted on multiple accesses to the same memory bank, during DRAM refreshing, or during accesses from Port B if dual accessing is used (DP8422A only).

In the 80286 READY LOGIC, the 74AS374 flip-flop that produces the D2 output has some gating at its inputs. This gating is used to synchronize the D2 output to the 80286 PCLK so as to end the access at the correct time.

The user can choose non-address pipelined mode for this design as long as the parameter " $\overline{AREQ}$  negated to CLK high minimum to guarantee tASR = 0 ns" is guaranteed

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(45 ns minimum for the 8422A-20, 39 ns for the 8422A-25). At 20 MHz, the user should choose address pipelined mode since it is not possible to meet the above parameter (50 ns one clock -8 ns 74AS374 max delay -4.5 ns 74AS00 max delay +1 ns min 74AS00 CLOCK delay =38.5 ns which is less than the 39 ns the DP8422A-25 needs). The user should also keep in mind that when using the DP8422A in address pipelined mode the DRAMs chosen need a minimum column address hold time of 32 ns.

### DESCRIPTION OF DESIGN #3, ALLOWS UP TO 25 MHz OPERATION (CLOCK OUTPUT OF THE 82284) WITH ONE WAIT STATE USING THE 80286-12

Design #3 (see *Figures 6, 7, 8*) is very similar to Design #2 except for the following changes:

- A. The circuit that produces SRDY, the gate signal for the 74AS373 transparent latches, and AREO has been changed to use DTACK2, a 74AS175 flip-flop, and some logic gates. This was needed because the 84288-12 was not known to be available, and also for speed in producing the gating signal of the 74AS373,
- B. The AREQ input was gated with CS using gate "U2". This was done to guarantee that the DTACK2 output becomes defined after power up,
- C. This design will work at 25 MHz and possibly beyond, if the 80286 is ever produced at faster speeds (see the TIMING section for Design #3),
- D. This design has one wait state inserted in normal sequential accesses, multiple wait states may be inserted on multiple accesses to the same memory bank, during DRAM refreshing, or during accesses from Port B if dual accessing is used (DP8422A only).

The user can choose non-address pipelined mode for this design as long as the parameter "AREQ negated to CLK high minimum to guarantee tASR = 0 ns" is guaranteed (45 ns minimum for the 8422A-20, 39 ns for the 8422A-25). At 25 MHz, the user must choose address pipelined mode since it is not possible to meet the above parameter (40 ns one clock - 7.5 ns 74AS175 max delay - 1 ns min 74AS00 CLOCK delay = 33.5 ns which is less than the 39 ns the DP8422A-25 needs). The user should also keep in mind that when using the DP8422A in address pipelined mode the DRAMs chosen need a minimum column address hold time of 32 ns.

In the 80286 READY LOGIC, the 74AS175 flip-flop that produces the D4 output has some gating at its inputs. This gating is used to synchronize the D4 output to the 80286 PCLK so as to end the access at the correct time.

### 80286 DESIGN # 1, UP TO 16 MHz WITH NO WAIT STATES, PROGRAMMING MODE BITS

| Programming<br>Bits | Description                                      |
|---------------------|--------------------------------------------------|
| R0=0                | RAS low two clocks, RAS precharge of             |
| R1=1                | two clocks. It should be noted that the          |
|                     | user should choose R0,1 = 11 when                |
|                     | operating above 16 MHz to allow                  |
|                     | enough RAS precharge time                        |
| R2=1                | DTACK low one clock from RAS low                 |
| R3=0                |                                                  |
| R4=0                | No WAIT states during burst accesses             |
| R5=0                |                                                  |
| R6=1                | If WAITIN = 0, add two clocks to DTACK           |
| R7=1                | Select DTACK                                     |
| R8=X                | The user may choose address pipelined            |
|                     | mode (R8=0) remember to choose                   |
|                     | DRAMs with column address hold times             |
|                     | of 32 ns or less, or non-address                 |
|                     | pipelined mode (R8=1), at clock                  |
|                     | frequencies below 16 MHz.                        |
| R9=X                |                                                  |
| C0=X                | Select based upon the input clock                |
| C1=X                | frequency. Example: if the input clock           |
| C2=X                | frequency is 12 MHz then choose                  |
|                     | C0,1,2=0,0,1 (divide by six, this will           |
|                     | give a frequency of 2 MHz).                      |
| C3=X                |                                                  |
| C4=1                | RAS and CAS groups selected by "B1".             |
| C5=1                | This mode allows two RAS and two                 |
| C6=1                | CAS outputs to go low during an                  |
|                     | access, and allows byte writing in 16-bit words. |
| C7=1                | Column address setup time of 0 ns.               |
| C8 = 1              | Row address hold time of 15 ns.                  |
| C9=1                | Delay CAS during write accesses to one           |
|                     | clock after RAS transitions low                  |
| B0=1                | Fall-thru latches                                |
| B1=0                | Access mode 0                                    |
| ECAS0=0             | Non-extend CAS mode                              |

0 = Program with low voltage level

1 = Program with high voltage level

X = Program with either high or low voltage level (don't care condition)

# 80286 DESIGN #2, UP TO 20 MHz WITH NO WAIT STATES, PROGRAMMING MODE BITS

| Programming<br>Bits | Description                                          |
|---------------------|------------------------------------------------------|
| R0 = 1              | RAS low four clocks, RAS precharge of                |
|                     | three clocks                                         |
| R1 = 1              |                                                      |
| R2=0                | DTACK low from RAS low                               |
| R3=0                |                                                      |
| R4=0                | No WAIT states during burst accesses                 |
| R5=0                |                                                      |
| R6=0                | If $\overline{\text{WAITIN}} = 0$ , add one clock to |
|                     | DTACK. Since we are not using the                    |
|                     | WAITIN input it should be tied high on               |
|                     | the DP8422A.                                         |
| R7 = 1              | Select DTACK                                         |
| R8 = X              | The user may choose address pipelined                |
|                     | mode (R8 $=$ 0), remember to choose                  |
|                     | DRAMs with column address hold times                 |
|                     | of 32 ns or less or non-address                      |
|                     | pipelined mode (R8 = 1), at clock                    |
|                     | frequencies below 20 MHz                             |
| R9=X                |                                                      |
| C0 = X              | Select based upon the input clock                    |
| C1 = X              | frequency. Example: if the input clock               |
| C2=X                | frequency is 16 MHz then choose                      |
|                     | C0,1,2 = 0,1,0 (divide by eight, this will           |
|                     | give a frequency of 2 MHz).                          |
| C3=X                |                                                      |
| C4 = 1              | RAS and CAS groups selected by "B1".                 |
| C5 = 1              | This mode allows two RAS and CAS                     |
| C6=1                | outputs to go low during an access, and              |
|                     | allows byte writing in 16-bit words.                 |
| C7 = 1              | Column address setup time of 0 ns.                   |
| C8 = 1              | Row address hold time of 15 ns.                      |
| C9=1                | Delay CAS during write accesses to one               |
|                     | clock after RAS transitions low                      |
| B0=1                | Fall-thru latches                                    |
| B1=0                | Access mode 0                                        |
| ECAS0=0             | Non-extend CAS mode                                  |

#### 0 = Program with low voltage level

1 = Program with high voltage level

X = Program with either high or low voltage level (don't care condition)

# 80286 DESIGN #3, UP TO 25 MHz WITH ONE WAIT STATE, PROGRAMMING MODE BITS

| STATE, PROGRAMMING MODE BITS |                                                                           |  |  |  |
|------------------------------|---------------------------------------------------------------------------|--|--|--|
| Programming<br>Bits          | Description                                                               |  |  |  |
| R0=1                         | RAS low four clocks, RAS precharge of                                     |  |  |  |
|                              | three clocks                                                              |  |  |  |
| R1=1                         |                                                                           |  |  |  |
| R2=1                         | DTACK low one clock from RAS low                                          |  |  |  |
| R3=0                         |                                                                           |  |  |  |
| R4=0                         | No WAIT states during burst accesses                                      |  |  |  |
| R5=0                         |                                                                           |  |  |  |
| R6=0                         | If $\overline{\text{WAITIN}} = 0$ , add one clock to                      |  |  |  |
|                              | DTACK. Since we are using DTACK2                                          |  |  |  |
|                              | the WAITIN input should be tied low on                                    |  |  |  |
|                              | the DP8422A.                                                              |  |  |  |
| R7=1                         | Select DTACK                                                              |  |  |  |
| R8=X                         | The user must choose address                                              |  |  |  |
|                              | pipelined mode ( $R8 = 0$ ), at clock                                     |  |  |  |
|                              | frequencies above 20 MHz. Also                                            |  |  |  |
|                              | remember to choose DRAMs with<br>column address hold times of 32 ns or    |  |  |  |
|                              | less or non-address pipelined mode                                        |  |  |  |
|                              | (R8 = 1), at clock frequencies below                                      |  |  |  |
|                              | 20 MHz                                                                    |  |  |  |
| R9=X                         | 20 101 12                                                                 |  |  |  |
| C0 = X                       | Select based upon the input clock                                         |  |  |  |
| C1 = X                       | frequency. Example: if the input clock                                    |  |  |  |
| C2=X                         | frequency is 12 MHz then choose                                           |  |  |  |
|                              | C0,1,2 = 0,0,1 (divide by six, this will                                  |  |  |  |
|                              | give a frequency of 2 MHz). For a CPU                                     |  |  |  |
|                              | frequency of 24 MHz the clock could be                                    |  |  |  |
|                              | divided by two initially to give a 12 MHz                                 |  |  |  |
|                              | input to the DELCLK input of the                                          |  |  |  |
|                              | DP8422A.                                                                  |  |  |  |
| C3=X                         |                                                                           |  |  |  |
| C4=1                         | RAS and CAS groups selected by "B1".                                      |  |  |  |
| C5=0                         | This mode allows two RAS and two                                          |  |  |  |
| C6=1                         | CAS outputs to go low during an                                           |  |  |  |
|                              | access, and allows byte writing in 16-bit                                 |  |  |  |
|                              | words.                                                                    |  |  |  |
| C7=1                         | Column address setup time of 0 ns.                                        |  |  |  |
| C8=1                         | Row address hold time of 15 ns.                                           |  |  |  |
| C9=1                         | Delay CAS during write accesses to one<br>clock after RAS transitions low |  |  |  |
| P01                          |                                                                           |  |  |  |
| B0=1<br>B1=0                 | Fall-thru latches<br>Access mode 0                                        |  |  |  |
| $\overline{ECAS0} = 0$       | Non-extend CAS mode                                                       |  |  |  |
| EUA30-0                      |                                                                           |  |  |  |

0 = Program with low voltage level

1 = Program with high voltage level

X = Program with either high or low voltage level (don't care condition)

#### 80286, DESIGN # 1, ACCESS MODE 0, 16 MHz TIMING (80286-8) WITH NO WAIT STATES DURING SEQUENTIAL ACCESSES

- Maximum time to address valid: <u>MRDC</u>, <u>MWTC</u> make 74AS373 fall-thru at 25 ns (max) from CLOCK low + 5.5 ns (74AS08) + 11.5 ns (74AS373 enable time) = 42 ns
- 2a. Maximum time to ALE high from CLOCK:
   40 ns (max status valid) + 4.5 ns (74AS00) = 44.5 ns
- 2b. Maximum time to ALE high from CLOCK (DP8422A CLK):

40 ns (max status valid) + 0 ns (74AS00 delays of CLOCK and ALE cancel out) = 40 ns

 Minimum ALE high setup time to CLOCK high (DP8422A-20 needs 16 ns):

62.5 ns (one clock period) - 40 ns (#2b, the 74AS00 U1 delays in the CLOCK and the ALE path will cancel out) = 22.5 ns

 Minimum address setup time to CLOCK high (DP8422A-20 needs 20 ns):

 $\frac{62.5}{\text{CLOCK}}$  ns (one clock period) + 1 ns (min 74AS00 delay,  $\frac{1}{\text{CLOCK}}$  - 42 ns (#1) = 21.5 ns

5a. Maximum CS valid time from CLOCK high:

60 ns (maximum address valid from phase two of previous clock) + 22 ns (maximum prop delay of 74ALS138) - 1 ns (minimum 74AS00 CLOCK delay) = 81 ns, THIS IS EQUAL TO 18.5 NS FROM PHASE ONE OF THE CURRENT "TS" INVERTED CLOCK (CLOCK,

81 ns - 62.5 ns = 18.5 ns).

5b. Maximum time to active high gating signal to 74AS373 transparent latch from CLOCK:

25 ns (MRDC, MWRC maximum delay to inactive) + 5.5 ns (maximum 74AS08 delay) - 1 ns (minimum 74AS00 CLOCK delay) = 29.5 ns,

AS CAN BE SEEN  $\overline{CS}$  PRECEDES THIS ACTIVE HIGH GATING SIGNAL, THEREFORE THE MAXIMUM TIME TO THE GATING SIGNAL DETERMINES THE MAXI-MUM TIME TO A VALID CHIP SELECT.

5c. Minimum CS setup time to CLOCK high (DP8422A-20 needs 14 ns):

62.5 ns (one clock period) - 29.5 ns (#5b) - 11.5 ns (maximum enable time to valid output for 74AS373) = 21.5 ns

6. Determining tRAC (RAS access time needed by the DRAM):

250 ns (TS + TC) - 62.5 ns (one clock) - 4.5 ns (74AS04 delay) - 10 ns (data setup time) - 7.5 ns (74AS245) - 32 ns (CLK to  $\overrightarrow{\text{RAS}}$  low on DP8422A-25) = 133.5 ns

Therefore the tRAC of the DRAM must be 133.5 ns or less.

 Determining tCAC (CAS access time) and column address access time needed by the DRAM:

250 ns - 62.5 - 4.5 - 10 ns - 7.5 ns - 89 ns (CLK to  $\overline{\text{CAS}}$  low on DP8422A-25) = 76.5 ns

Therefore the tCAC of the DRAM must be 76.5 ns or less.

- Maximum time to DTACK1 low:
   62.5 ns (One clock) + 4.5 ns (max 74AS04 CLOCK delay) +41 ns (DTACK0 low from CLK high) = 108 ns
- 9. Minimum DTACK1 setup time to SRDY being sampled (15 ns is needed by the 80286):

125 ns (two clock periods) -108 ns (#8) = 17 ns

\*\*\*\*\*IF FASTER SPEEDS ARE DESIRED THE USER CAN USE THE DP8422A-25.

## 80286, DESIGN #2, ACCESS MODE 0, 20 MHz TIMING (80286-10) WITH ZERO WAIT STATES DURING SEQUENTIAL ACCESSES

1. Maximum time to address valid:

The "G" input makes the 74AS373 fall-thru at 8 ns (max) from CLOCK high (8 ns max delay of 74AS374 low to high) + 11.5 ns (74AS373 enable time) = 19.5 ns

2a. Maximum time to ALE high from CLOCK:

28 ns (max status valid) + 4.5 ns (74AS00) = 32.5 ns

2b. Maximum time to ALE high from CLOCK (DP8422A CLK):

28 ns (max status valid) + 0 ns (74AS00 delays of CLOCK and ALE cancel out) = 28 ns

3. Minimum ALE high setup time to CLOCK high (DP8422A-25 needs 15 ns):

50 ns (one clock period) - 28 ns (#2b, the 74AS00 U1 delays in the CLOCK and the ALE path will cancel out) = 22 ns

 Minimum address setup time to CLOCK high (DP8422A-25 needs 18 ns):

50 ns (one clock period) - 19.5 ns (#1) = 30.5 ns

5a. Maximum CS valid time from CLOCK high:

47 ns (maximum address valid from phase two of previous clock) + 22 ns (maximum prop delay of 74ALS138) - 1 ns (minimum 74AS00 CLOCK delay) = 68 ns, THIS IS EQUAL TO 18 NS FROM PHASE ONE OF

THE CURRENT "TS" INVERTED CLOCK (CLOCK). 5b. Maximum time to AREQ (active high gating signal to 74AS373 transparent latch from CLOCK:

8 ns (max delay of gate (D1) output of 74AS374 low to high from  $\overline{\text{CLOCK}}$  + 4.5 ns (74AS00,  $\overline{\text{AREQ}}$  is output) = 12.5 ns

AS CAN BE SEEN CS SUCCEEDS THIS ACTIVE HIGH GATING SIGNAL, THEREFORE THE MAXIMUM TIME TO CHIP SELECT DETERMINES THE MAXIMUM TIME TO A VALID LATCHED CHIP SELECT.

5c. Minimum CS setup time to CLOCK high (DP8422A-25 needs 13 ns):

50 ns (one clock period) - 18 ns (#5a) - 11.5 ns (maximum enable time to valid output for 74AS373) = 20.5 ns

6. Determining tRAC (RAS access time needed by the DRAM):

200 ns (TS + TC) - 50 ns (one clock) - 4.5 ns (74AS04 delay,  $\overline{\text{CLOCK}}$ ) - 8 ns (data setup time) - 7.5 ns (74AS245) - 26 ns (CLK to  $\overline{\text{RAS}}$  low on DP8422A-25) = 104 ns

Therefore the tRAC of the DRAM must be 104 ns or less.

7. Determining tCAC (CAS access time) and column address access time needed by the DRAM:

200 ns - 50 - 4.5 - 8 ns - 7.5 ns - 79 ns (CLK to  $\overline{\text{CAS}}$  low on DP8422A-25) = 51 ns

Therefore the tCAC of the DRAM must be 51 ns or less.

 Minimum setup time of D0 low (from DTACK0) to CLOCK (74AS374 needs 3 ns):
 50 ns (one clock) - 33 ns (DTACK0 low from CLK

high) - 4.5 ns (max delay of 74AS02) = 12.5 ns

 Minimum PCLK setup to CLOCK (rising edge of 74AS374, needs 3 ns):
 50 ns (one clock) - 35 ns (max PCLK delay) - 5 ns

(max 74AS04 delay) - 4.5 ns (max delay of 74AS02) = 5.5 ns

10. Minimum SRDY setup time to clock where it is sampled (15 ns is needed by the 80286):

50 ns (one clock period) - 8 ns (max delay low to high of "Q" output of 74AS374) - 4.5 ns (max delay of 74AS00) - 4.5 ns (max delay of 74AS00,  $\overline{\text{CLOCK}}$ ) = 33 ns

## 80286, DESIGN #3, ACCESS MODE 0, 25 MHz TIMING (80286-12) WITH ONE WAIT STATE DURING SEQUENTIAL ACCESSES

- Maximum time to address valid: The "G" input makes the 74AS373 fall-thru at 7.5 ns (max) from CLOCK high (7.5 ns max delay of 74AS175 low to high) + 11.5 ns (74AS373 enable time) = 19 ns
- Maximum time to ALE high from CLOCK:
   22 ns (max status valid) + 4.5 ns (74AS00) = 26.5 ns
- 2b. Maximum time to ALE high from CLOCK (DP8422A CLK):

 $\frac{22}{\text{CLOCK}}$  ns (max status valid) + 0 ns (74AS00 delays of  $\frac{1}{\text{CLOCK}}$  and ALE cancel out) = 22 ns

 Minimum ALE high setup time to CLOCK high (DP8422A-25 needs 15 ns):
 AD no (ano clock partiad) 22 no (# 2h the ZAAS00 Lt1

40 ns (one clock period) - 22 ns (#2b, the 74AS00 U1 delays in the  $\overline{\text{CLOCK}}$  and the ALE path will cancel out) = 18 ns

4. Minimum address setup time to CLOCK high (DP8422A-25 needs 18 ns):

40 ns (one clock period) -19 ns (#1) = 21 ns

5a. Maximum CS valid time from CLOCK high:

37 ns (maximum address valid from phase two of previous clock) + 14 ns (maximum prop delay of 74ALS139) - 1 ns (minimum 74AS00  $\overline{\text{CLOCK}}$  delay) = 50 ns, THIS IS EQUAL TO 10 NS FROM PHASE ONE OF

THE CURRENT "TS" INVERTED CLOCK (CLOCK).

5b. Maximum time to active high gating signal to 74AS373 transparent latch from CLOCK:

7.5 ns (max delay of gate ( $\overline{D3}$ ) output of 74AS175 low to high from  $\overline{CLOCK}$ )

AS CAN BE SEEN  $\overline{\rm CS}$  SUCCEEDS THE ACTIVE HIGH GATING SIGNAL, THEREFORE THE MAXIMUM TIME TO  $\overline{\rm CS}$  VALID DETERMINES THE MAXIMUM TIME TO A VALID CHIP SELECT.

5c. Minimum CS setup time to CLOCK high (DP8422A-25 needs 13 ns):

40 ns (one clock period) - 10 ns (#5a) - 11.5 ns (maximum enable time to valid output for 74AS373) = 18.5 ns

6. Determining tRAC (RAS access time needed by the DRAM):

240 ns (TS + TC + TC) - 40 ns (one clock) - 4.5 ns (74AS04 delay,  $\overline{\text{CLOCK}}$ ) - 8 ns (data setup time) - 7.5 ns (74AS245) - 26 ns (CLK to  $\overline{\text{RAS}}$  low on DP8422A-25) = 154 ns

Therefore the tRAC of the DRAM must be 154 ns or less.

 Determining tCAC (CAS access time) and column address access time needed by the DRAM:

240 ns - 40 - 4.5 - 8 ns - 7.5 ns - 79 ns (CLK to CAS low on DP8422A-25) = 101 ns

Therefore the tCAC of the DRAM must be 101 ns or less.

8. Minimum setup time of D2 low (from DTACK2) to CLOCK (74AS175 needs 3 ns):

40 ns (one clock) - 28 ns (DTACK2 low from CLK high) - 4.5 ns (max delay of 74AS02) = 7.5 ns

9. Minimum SRDY setup time to clock where it is sampled (15 ns is needed by the 80286):

40 ns (one clock period) - 10 ns (max delay high to low of  $\overline{Q}$  output of 74AS175) - 4.5 ns (max delay of 74AS00,  $\overline{CLOCK}$ ) = 25.5 ns

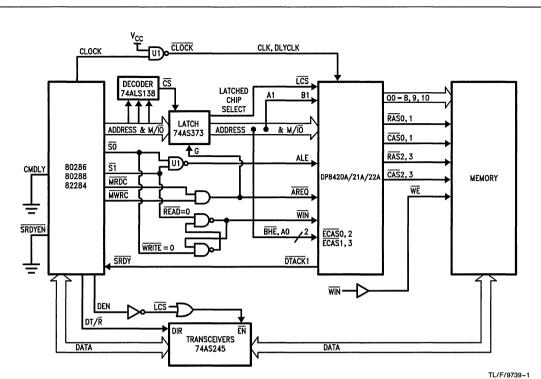
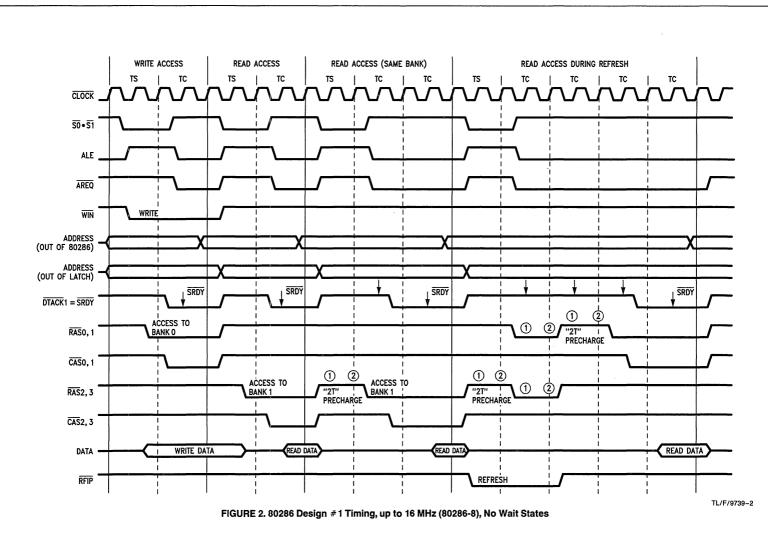
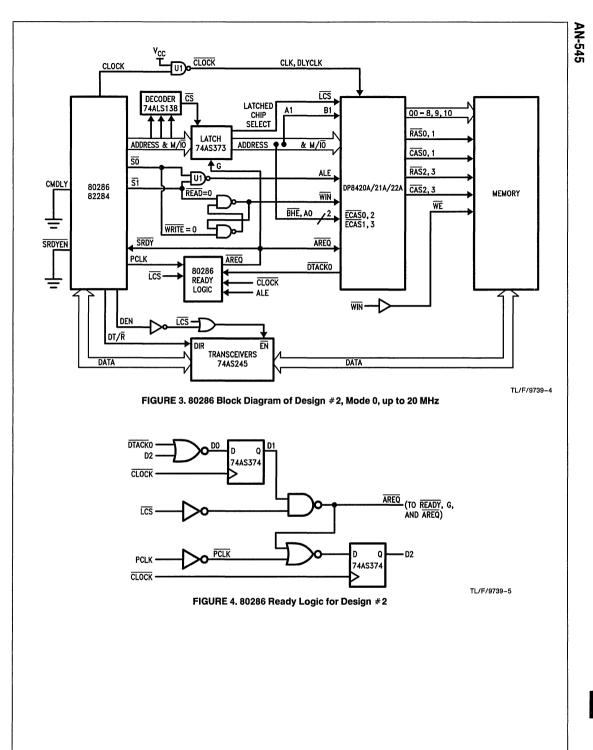


FIGURE 1. 80286 Block Diagram of Design # 1, Mode 0, up to 16 MHz

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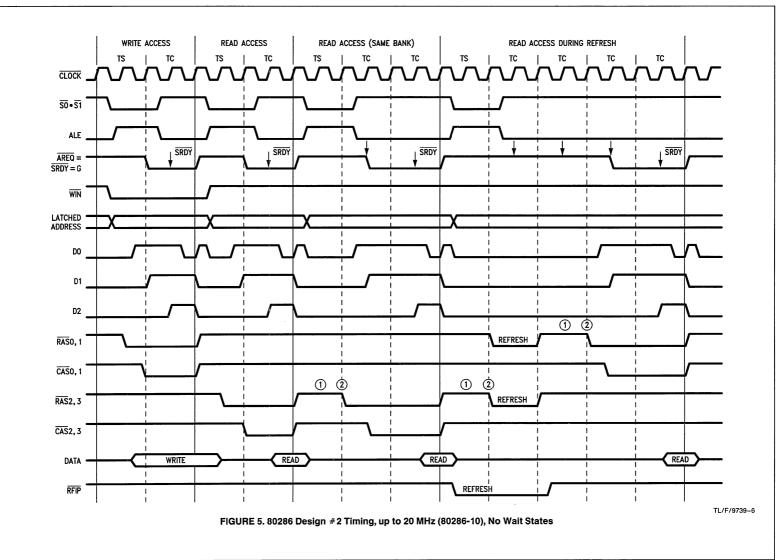
4-124

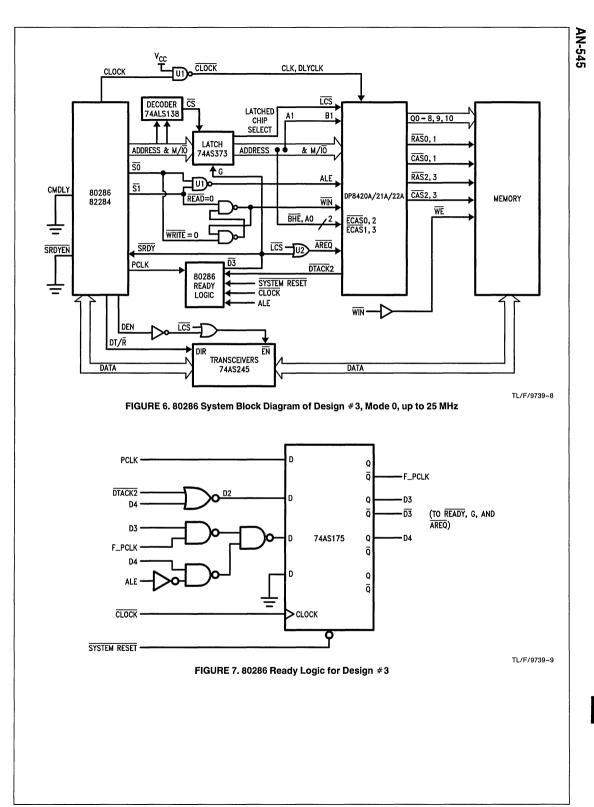




4-125

4

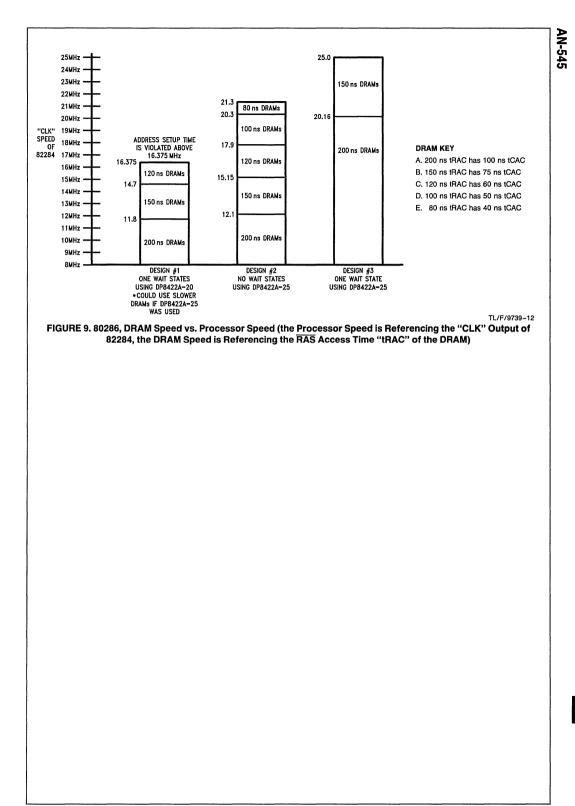




4

WRITE ACCESS READ ACCESS READ ACCESS (SAME BANK) READ ACCESS DURING REFRESH TS | TC TC TS | TC TC TS | TC | TC | TC 50 • 51 ALE AREQ WIN LATCHED ADDRESS D2 D3 D3 = G = SRDY PCLK SYNCHRONIZES D4 IN THESE TWO ACCESSES D4 RASO, 1 **RAS2, 3** WRITE READ READ READ DATA RFIP TL/F/9739-10 FIGURE 8. 80286 Design #3 Timing, up to 25 MHz (80286-12), with One Wait State per Access

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# A PAL Interface for a 25 MHz and above No-Wait State DP8422A/80286 Burst Mode DRAM Memory System

# I. INTRODUCTION

This application note describes a two PAL designs that interface the DP8422A to the 80286 CPU. The first design allows the 80286 to be operated at up to 40 MHz (80286-20) with one wait state inserted during normal accesses. The second design allows the 80286 to operate at up to 40 MHz (80286-20) with zero wait states inserted when operating the DRAMs in page mode. Design number two also makes use of the 74ALS6311 page detector to determine whether the 80286 current access is within the same page as the previous access. It is assumed that the reader is familiar with the 80286, the DP8422A DRAM controller, the 74ALS6311 and the basics of PAL design.

### II. DESCRIPTION OF DESIGN # 1, 80286 OPERATING AT UP TO 40 MHz WITH ONE WAIT STATED (80286-20)

The block diagram of this design is shown driving two banks of DRAM, each bank being 16 bits in width, giving a maximum memory capacity of up to 4 Mbytes (using 1 Mbit x 1 DRAMs). This memory could easily be expanded up to 32 Mbytes using four banks of 4 Mbit DRAMs.

The memory banks are interleaved on word (16-bit word) boundaries. This means that the address bit (A1) is tied to the bank select input of the DP8422A (B1).

Address bit A0 is used, along with Bus High Enable (BHE), to produce the two byte select ECAS  $\sim$  0,1 strobes. These byte select strobes (ECAS  $\sim$  0,1) enable the CAS  $\sim$  outputs which are used in byte reads and writes.

If the majority of accesses made by the 80286 are sequential, the 80286 can alternate memory banks, allowing one memory bank to be precharging (RAS  $\sim$  precharge) while the other banks are being accessed. Each separate memory access to the same memory bank will require extra wait states to be inserted into the CPU access cycles to allow for the RAS  $\sim$  precharge time.

This application inserts 1 wait state in normal accesses of the 80286. The number of wait states can be adjusted through the WAITIN input of the DP8422A.

The logic shown in this application note forms a complete 80286 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A. Arbitration between Port A, Port B, and refreshing the DRAM;
- B. The insertion of wait states to the processor (Port A and Port B) when needed (i.e., if RAS ~ precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access . . . etc);

C. Performing byte writes and reads to the 16-bit words in memory.

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It is important that the 74AS00 NAND gates (U1) be in the same package so these delays (CLK  $\sim,$  S01) track each other.

By using the "output control" pins of some external latches (74AS373's), this application can easily be used in a dual access application. The addresses could be tri-stated through these latches, the write input (WIN~), lock input (LOCK~), and ECAS~0-3 inputs must also be able to be tri-stated (a 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B) the DP8422A can be used in a dual access application. If this design is used in a dual access application. If this design is used in a dual access time required by the DRAM) will have to be recalculated since the time to RAS and CAS is longer for the dual access application (see TIMING section of this application note).

Also, throughout this application note the symbol '~' has been used to denote and active low signal. For example RAS~0 refers to the active low RAS0 output of the DP8421A. For even higher system performance an 'E' speed PAL can be used.

## III. DESCRIPTION OF DESIGN #2, 80286 OPERATING AT UP TO 40 MHz (80286-20) WITH ZERO WAIT STATES USING PAGE MODE DRAMS

This design is very similar with respect to design #1 except for the following differences.

The memory banks are interleaved on page (1024 word) boundaries. This means that the address bit (A11) is tied to the bank select input of the DP8421A (B1).

Address bit A0 is used, along with Bus High Enable (BHE), to produce the two byte select ECAS  $\sim$  0,1 strobes. These byte select strobes (ECAS  $\sim$  0,1) are logically "ORed" with the DP8421A CAS  $\sim$  outputs to produce the byte selecting CAS  $\sim$  inputs to the DRAMs.

If the majority of accesses made by the 80286 are sequential and within a page, the 80286 in conjunction with the page detector (74ALS6311) allow zero wait state accessing. Each in-page memory access is completed using page mode (toggling the CAS $\sim$  inputs).

As in design #1 it is important that the 74AS00 NAND gates (U1) be in the same package so the delays (CLK $\sim$ , S01) track each other. For even higher system performance an 'E' speed PAL could be used.

# IV. 80286 DESIGNS #1 AND #2 PROGRAMMING MODE BITS

| Programming<br>Bits                  | Description                                                                                                                                                                                                          |
|--------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R0 = 0<br>R1 = 1                     | $RAS \sim low two clocks, RAS \sim$<br>precharge of two clocks. If more<br>$RAS \sim$ precharge is desired the<br>user should program three<br>periods of RAS $\sim$ precharge.                                      |
| R2 = 0<br>R3 = 1                     | DTACK $\sim \frac{1}{2}$ is chosen.<br>DTACK $\sim$ follows the access                                                                                                                                               |
| R4 = 0                               | RAS ~ low.<br>No WAIT states during burst                                                                                                                                                                            |
| R5 = 0                               | accesses.                                                                                                                                                                                                            |
| R6 = 0                               | If WAITIN $\sim = 0$ , add one clock<br>to DTACK $\sim$ . WAITIN $\sim$ may be<br>tied high or low in this<br>application depending upon the<br>number of wait states the user<br>desires to insert into the access. |
| R7 = 1                               | Select DTACK~.                                                                                                                                                                                                       |
| R8 = 1<br>R9 = X                     | Non-interleaved Mode.                                                                                                                                                                                                |
| C0 = X<br>C1 = X<br>C2 = X<br>C3 = X | Select based upon the input<br>"DELCLK" frequency. Example:<br>if the input clock frequency is<br>16 MHz then choose C0, 1, $2 =$<br>0, 1, 0 (divide by eight, this will<br>give a frequency of 2 MHz).              |
| C4 = 1<br>C5 = 0<br>C6 = 1           | RAS banks selected by "B1".<br>This mode allows two RAS ~<br>outputs to go low during an<br>access, and allows byte writing<br>in 16 bit words.                                                                      |
| C7 = 1                               | Column address setup time of<br>0 ns.                                                                                                                                                                                |
| C8 = 1                               | Row address hold time of 15 ns.                                                                                                                                                                                      |
| C9 = 1                               | Delay CAS ~ during write<br>accesses to one clock after<br>RAS ~ transitions low.                                                                                                                                    |
| B0 = 1                               | Fall through latches.                                                                                                                                                                                                |
| B1 = 1                               | Access mode 1.                                                                                                                                                                                                       |
| ECAS~0 = 1                           | Allow CAS ~ to be extended<br>after RAS ~ transitions high.<br>Also, allow the WE ~ output to<br>be used as a refresh request<br>(RFRQ ~) output indicator.                                                          |

0 = Program with low voltage level 1 = Program with high voltage level

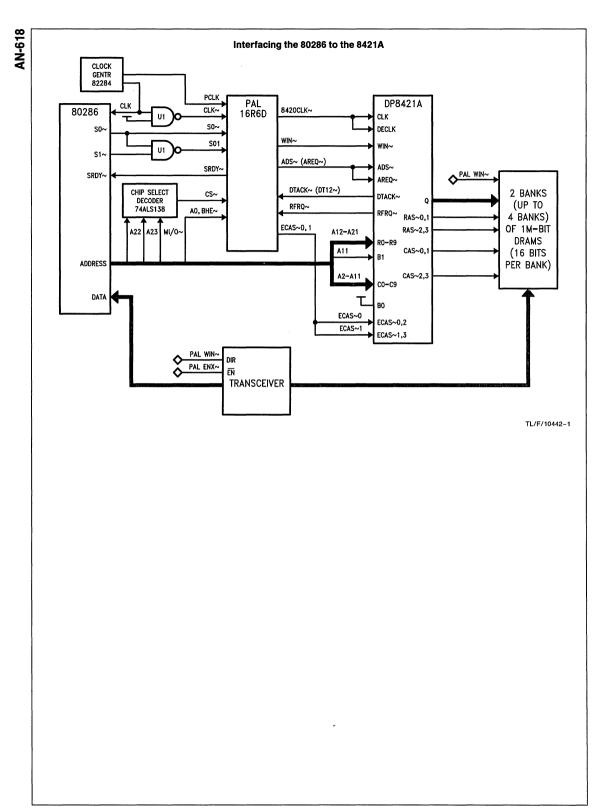
X = Program with either high or low voltage level (don't care condition)

1. Minimum S01 high setup time to CLK~ high ('D' speed PAL needs 8 ns): 31.25 ns (one clock period, 32 MHz) - 20 ns (maximum 80286 S0~, S1~ delay, #12a) - 1 ns (maximum skew between CLK ~ and S0 ~, S1 ~ since both gates are in the same package) = 10.25 ns. 2. Maximum address valid time (with respect to CLK~ high during phase 1 in Ts): 62.5 ns (two clocks 32 MHz) - 31 ns (80286 address valid delay from previous clock period, #15) + 1 ns (minimum CLK ~ valid delay, 74AS00) = -1.25 ns (before CLK~ high phase 1 Ts). 3. Minimum address setup time to ADS~ low (DP8421A-25 needs 14 ns, #404): 31.25 ns (one clock period) + 1.25 ns (from #2 calculation above) + 2 ns (minimum ADS~ valid delay from CLK~ high, beginning of phase 2 in Ts) = 34.5 ns address setup. 4. Minimum CS setup time to ADS~ low (DP8421A-25 needs 5 ns, #401): 34.5 ns (#3 above) - 10 ns (max 74ALS138 decoder) = 24.5 ns. 5. Determining tRAC during a normal access (RAS~ access time needed by the DRAM): 156.25 ns (five clock (CLK) periods to do the access) -4.5 ns (max delay 74AS00 for CLK~) - 8 ns (max 'D' speed PAL clocked output delay for ADS~ from CLK~) - 29 ns (ADS~ to RAS~ low max, DP8421A-25 #402) - 7 ns (80286 data setup time #8) - 7 ns (74F245 max delay) = 100.75 ns. Therefore the tRAC of the DRAM must be 100.75 ns or less. 6. Determining tCAC during a normal access (CAS~ access time) and column address access time needed by the DRAM: 156.25 ns (five clock (CLK) periods to do the access) -4.5 ns (max delay 74AS00 for CLK ~) -8 ns (max 'D' speed PAL clocked output delay for ADS ~ from CLK ~) - 82 ns (ADS~ to RAS~ low max, DP8421A-25 #402) - 7 ns (80286 data setup time #8) - 7 ns (74F245 max delay) = 47.75 ns. Therefore the tCAC and the column address access time of the DRAM must be 47.75 ns or less. 7. Determining the column address setup time to CAS~0-3 low (0 ns needed by the DRAMs) during burst mode accesses for zero wait states (DESIGN #2 ONLY): 31.25 ns (phase 1 in Ts) + 1.25 ns (#2 above, address valid with respect to CLK~ beginning of phase 1 in Ts) + 2 ns (minimum 'D' speed PAL clocked output delay

This gives 1.5 ns column address setup time to CAS  $\sim$  0–3 low (36.5 ns - 35 ns 8421A-25 column address input to output valid, #26).

from CLK ~, ECAS ~ 0,1) + 2 ns (74AS32 min delay to

 $CAS \sim 0-3 \text{ low}) = 36.5 \text{ ns.}$ 



 Determining the tCAC (CAS ~ access time) needed during burst mode accesses for zero wait states (DESIGN #2 ONLY):

93.75 ns (three clocks of CLK) – 4.5 ns (74AS00 max delay, CLK~) – 8 ns ('D' speed PAL clocked output delay from CLK~, ECAS~0,1) – 10 ns (74AS32 max delay to CAS~0–3 low) – 7 ns (80286 data setup time #8) – 7 ns (74F245 max delay) = 57.25 ns tCAC needed.

 Determining the column address access time needed during burst mode accesses for zero wait states (DE-SIGN #2 ONLY):

57.25 ns (#8 above, tCAC needed by the DRAM) + 1.5 ns (#7 above, column address setup time to  $CAS \sim 0-3$  low) = 58.75 ns.

 Minimum SRDY~ (Synchronous ReaDY) setup time to CLK low (80286 SRDY input needs 15 ns, #11):

62.5 ns (two clock periods) - 4.5 ns (74AS00 max delay, CLK $\sim$ ) - 10 ns ('D' speed PAL combinational output max delay to SRDY $\sim$  low) = 48 ns.

Note: Calculations can be performed for different frequencies, different logic (ALS or CMOS ... etc), and/or different combinations of wait states by substituting the appropriate values into the above equations.

## VI. 80286 PAL INPUT AND OUTPUT DESCRIPTIONS FOR DESIGNS # 1 AND # 2

| FOR DESIGNS #1 AND #2 |                                                                                                                                                                 |  |
|-----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Inputs:               |                                                                                                                                                                 |  |
| CLK~                  | The inverted clock (CLK) of the 80286.                                                                                                                          |  |
| PCLK                  | The half speed clock of the 80286, produced by the 82284.                                                                                                       |  |
| S01                   | The 80286 S0 $\sim$ 'NANDed' with S1 $\sim$ .                                                                                                                   |  |
| S0~                   | The S0 $\sim$ output of the 80286.                                                                                                                              |  |
| WIN~                  | The 80286 S0 $\sim$ input low latched throughout the access cycle.                                                                                              |  |
| CS~                   | The DRAM chip select generated from the 80286 addresses.                                                                                                        |  |
| DT12~                 | The DTACK $\sim$ output of the 8421A.                                                                                                                           |  |
| A0                    | The least significant address bit (low byte enable) from the 80286.                                                                                             |  |
| BHE~                  | The high byte enable from the 80286.                                                                                                                            |  |
| RFRQ~                 | The refresh request output from the 8421A.                                                                                                                      |  |
| HSA~                  | The High Speed Access output (comparison equal) from the 74ALS6311.                                                                                             |  |
| OE~                   | Output enable of the PAL®.                                                                                                                                      |  |
| Outputs:              |                                                                                                                                                                 |  |
| ECAS~0                | The low byte CAS $\sim$ enable, this output also toggles during page mode accesses in design #2.                                                                |  |
| ECAS~1                | The high byte CAS $\sim$ enable, this output also toggles during page mode accesses in design #2.                                                               |  |
| SRDY~                 | This is the ready input to the 80286, it is used to insert wait states into 80286 access cycles.                                                                |  |
| 8420CLK~              | This is the CLOCK and DELCLK input to the 8421A. This clock runs at half of the 80286 CLK frequency.                                                            |  |
| ADS~                  | This is the ADS $\sim$ and AREQ $\sim$ inputs to the 8421A. In design #2 this input stays low thru multiple accesses as long as the accesses are within a page. |  |
|                       |                                                                                                                                                                 |  |

- NOACC~ This PAL output is low at the end of an 80286 access and stays low until the next access starts.
- LREQ~ In Design #2 this output latches that an access request occurred (from the 80286) during an out-of-page access or refresh request during page mode accessing.
- WIN ~ The latched S0 ~ output from the 80286.
- ENX ~ The PAL output used to enable the data transceivers.

# 80286 PAL EQUATIONS (DESIGN #1)

1. Up to 40 MHz (80286-20) PAL16R6D CLK~ PCLK S01 S0~ CS~ DT12~ A0 BHE~ NC3 GND OE~ ECAS~1 WIN~ ENX~ SRDY~ ADS~ NOACC~ 8420CLK~ ECAS~0 VCC If (V<sub>CC</sub>) /ECAS~0 = /CS~\*S01\*S0~\*/A0\*8420CLK~ ;READ +/CS~\*/ADS~\*/DT12~ \*/A0\*8420CLK~ :WRITE +/ECAS~0\*/ADS~ +/ECAS~0\*/SRDY~ If (V<sub>CC</sub>) /ECAS ~ 1 = /CS ~ \*S01\*S0 ~ \*/BHE~\*8420CLK~ ;READ +/CS~\*/ADS~\*/DT12~\* /BHE~\*8420CLK~ :WRITE +/ECAS~1\*/ADS~ +/ECAS~1\*/SRDY~ /8420CLK~ := /PCLK /NOACC~ := /SRDY~\*/ADS~ +/NOACC~\*/PCLK +/NOACC~\*CS~\*/ADS~ +/NOACC~\*/S01 /ADS~ := /CS~\*S01\*PCLK +/ADS~\*SRDY~ /SRDY~ := /CS~\*/ADS~\*/DT12~\*NOACC~\* /PCLK +/SRDY~\*/ADS~\*NOACC~ /ENX~ := /CS~\*/ADS~ /WIN~ := /S0~\*S01 +/WIN~\*NOACC~ +/WIN~\*/PCLK **80286 PAGE MODE PAL EQUATIONS** 

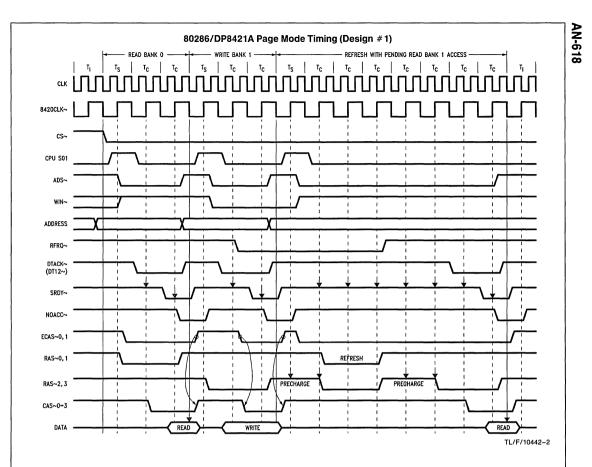
# 80286 PAGE MODE PAL EQUATIONS (DESIGN #2)

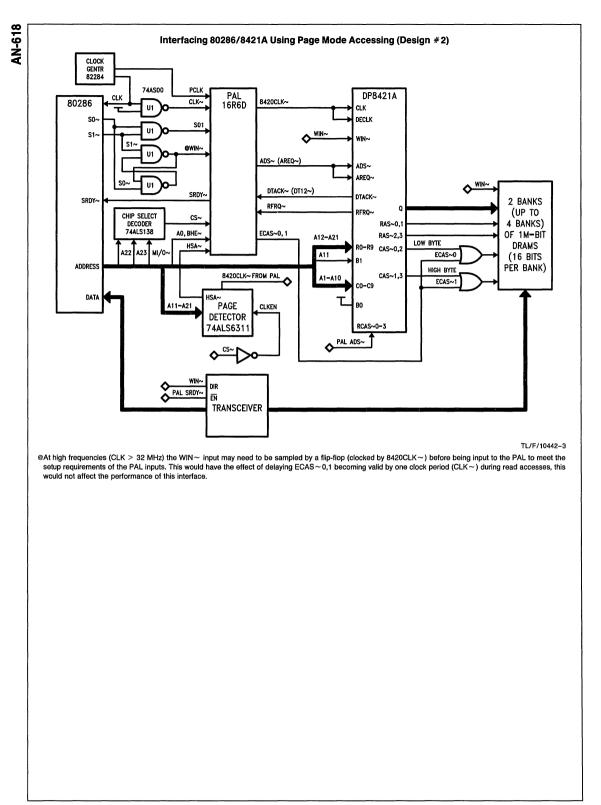
2. Up to 40 MHz (80286-20) PAL16R6D CLK~ PCLK S01 WIN~ CS~ DT12~ RFRQ~ HSA~ A0 GND OE~ BHE~ ADS~ LREQ~ NOACC~ 8420CLK~ ECAS~1 ECAS~0 SRDY~ VCC If (V<sub>CC</sub>)/SRDY~ = /CS~\*/ADS~\* /DT12~\*NOACC~\*8420CLK~ +/SRDY~\*/ADS~\*NOACC~ +/SRDY~\*/ADS~\*8420CLK~

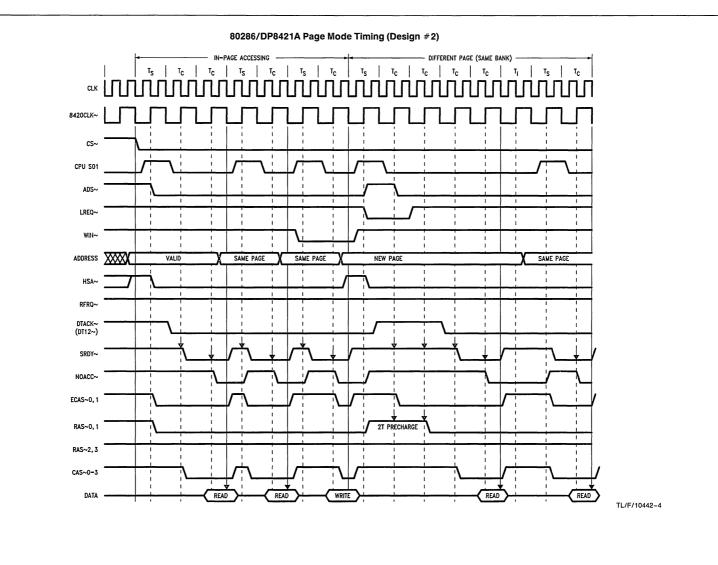
| /ECAS~0:= /CS~*S01*WIN~*/A0*/HSA~*PCLK   | ;READ WITH ADS~ LOW   |
|------------------------------------------|-----------------------|
| + /CS~ *S01*WIN~ */A0*HSA~ *ADS~ *PCLK   | ;READ WITH ADS~ HIGH  |
| +/CS~*/LREQ~*/A0*/HSA~*WIN~*PCLK         | ;READ DELAYED ACCCESS |
| +/CS~*/ADS~*/SRDY~*NOACC~*/A0*PCLK       |                       |
| + /ECAS~0*/ADS~*NOACC~                   |                       |
| /ECAS~1:= /CS~*S01*WIN~*/BHE~*/HSA~*PCLK | ;READ WITH ADS~ LOW   |
| +/CS~*S01*WIN~*/BHE~*HSA~*ADS~*PCLK      | ;READ WITH ADS~ HIGH  |
| +/CS~*LREQ~*/BHE~*/HSA~*WIN~*PCLK        | ;READ DELAYED ACCESS  |
| +/CS~*/ADS~*/SRDY~*NOACC~*/BHE~*PCLK     |                       |
| +/ECAS~1*/ADS~*NOACC~                    |                       |
| /8420CLK~ := /PCLK                       |                       |
| /NOACC~ := /SRDY~*/ADS~                  |                       |
| +/NOACC~*/PCLK                           |                       |
| +/NOACC~*CS~*/ADS~                       |                       |
| + /NOACC~*/S01                           |                       |
| /LREQ~:= /CS~*S01*HSA~*/ADS~             |                       |
| +/CS~*S01*/RFRQ~*/ADS~                   |                       |
| +/LREQ~*ADS~                             |                       |
| /ADS~:= CS~*S01*ADS~*RFRQ~*PCLK          |                       |
| +/LREQ~*/HSA~*PCLK                       |                       |
| +/ADS~*NOACC~                            |                       |
| +/ADS~*/NOACC~*RFRQ~*/HSA~               |                       |
|                                          |                       |

+/ADS~\*/NOACC~\*/PCLK

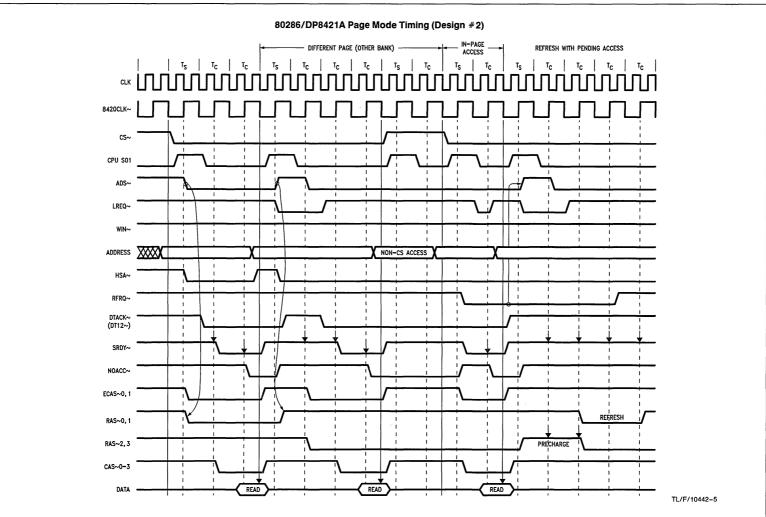
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4-138

# Interfacing the DP8420A/21A/22A to the 80386

National Semiconductor Application Note 536 Webster (Rusty) Meier Jr. and Joe Tate



AN-536

# INTRODUCTION

This application note describes how to interface the 80386 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). The 80386 is interfaced with the DP8422A in both address pipelined (Design # 1) and non-address pipelined (Design # 2) mode up to 50 MHz (80386-25). It is assumed that the reader is already familiar with 80386 access cycles and the DP8422A modes of operation.

#### I. DESCRIPTION OF DESIGN # 1A and 1B, THE 80386 IN ADDRESS PIPELINED MODE, ALLOWING OPERATION UP TO 40 MHZ (80386-25) WITH ONE WAIT STATE PER ACCESS. (TWO WAIT STATES PER ACCESS AT 50 MHZ)

The #1 Designs (80386 in address pipelined mode) consist of the DP8422A DRAM controller, a single PAL<sup>®</sup> (PAL16R8D), and several logic gates. These parts interface to the 80386 as shown in the block diagrams. This design accommodates two banks of DRAM, each bank being 32 bits in width, giving a maximum memory capacity of 32 Mbytes (using 4 Mbit x 1 DRAMs). See *Figures* 1–5.

Design #1A differs from #1B in terms of the maximum operating frequency. Design #1A can operate up to 40 MHz, Design #1B can operate up to 50 MHz. Designs #1A and B allow 1 wait state per access for read cycles and 2 wait states per access for write cycles in address pipelined mode.

The memory banks are two way interleaved. This means that the least significant address bit (A2) is tied to the bank select input of the DP8422A (B1). Because the majority of accesses made by the 80386 will be sequential, one memory bank can be precharging ( $\overline{RAS}$  precharge) while the other bank is being accessed. This allows the memory system to be much higher performance than a non-interleaved memory system. In a non-interleaved memory system, each successive access will generally be to the same memory bank thereby requiring extra wait states to be inserted into the CPU access cycles to allow for the  $\overline{RAS}$  precharge time.

In Designs 1A and 1B, the PAL (PAL16R8D) is used primarily to support the address pipelining capability of the 80386 (next address input, NA#). Since the NA# input is only allowed to drop low at the end of the current access no address latches are needed in the system. If address buffers were desired they could be used, but the DP8422A-25 would have to be used in order to meet the bank address and chip select setup times (see "80386 32 MHz Timing Calculations" section). An input is provided ( $EXT\_NA$ ) on the PAL for other system peripherals to have their NA inputs synchronized to the system clock (up to 50 MHz).

Designs 1A and 1B have one wait state during successive address pipelined accesses to alternating memory banks. During accesses to the same memory bank multiple wait states will be inserted to guarantee RAS precharge.

The "U2" gates need to all be part of the same chip to guarantee that "DIR" to the transceivers only changes state while enable to the transceivers is high.

If the user desires two wait states during successive address pipelined accesses (an extra wait state per access), this can be accomplished by running  $\overrightarrow{RAS0}$  and  $\overrightarrow{RAS2}$  through a flip-flop (clocked by CLKA) before allowing them to be input to the PAL in Design #18. This will delay  $\overrightarrow{NA}$  and  $\overrightarrow{READY}$  by one CLKA clock period. In Design #1A the  $\overrightarrow{WAITIN}$  input could be tied low and programmed to add 1 clock to the  $\overrightarrow{DTACK}$  output.

If the user wants to do dual accessing with the DP8422A DRAM controller, address buffers (74AS244s) must be added to the address, ECAS0-3, LOCK, and WIN inputs. For the 32 MHz system (80386–16), the system diagram will remain unchanged, but the user will need to use the faster DP8422A-25 part.

For higher frequency dual access memory systems (above 32 MHz), these designs will have to be modified as above. Also, CLKA should be inverted (use  $\overline{1Q}$  output from 74AS175). This will cause  $\overline{RAS}$  to be started one half CLKA clock period later, allowing extra address and chip select setup time to the DP8422A.

### II. DESCRIPTION OF DESIGN #2, (A, B, AND C). THE 80386 IN NON-ADDRESS PIPELINED MODE, ALLOWING OPERATION UP TO 40 MHZ (80386-20) WITH TWO WAIT STATES PER ACCESS (50 MHZ WITH THREE WAIT STATES)

Design #2A (80386 not using address pipelined mode) consists of the DP8422A DRAM controller, several flip-flops (74AS175), and several logic gates (see *Figure 7A*). Designs #2B, C are PAL based designs (see *Figures 7B, C*). These parts interface to the 80386 as shown in the block diagrams. This design accommodates two banks of DRAM, each bank being 32 bits in width, giving a maximum memory capacity of 32 Mbytes (using 4 Mbit x 1 DRAMs). See *Figures 6–10*.

The memory banks are two way interleaved. This means that the least significant address bit (A2) is tied to the bank select input of the DP8422A (B1). Because the majority of accesses made by the 80386 will be sequential, one memory bank can be precharging ( $\overline{RAS}$  precharge) while the other bank is being accessed. This allows the memory system to be much higher performance than a non-interleaved memory system. In a non-interleaved memory system, each successive access will generally be to the same memory bank thereby requiring extra wait states to be inserted into the CPU access cycles to allow for the  $\overline{RAS}$  precharge time.

Designs #2A, B, C have two wait states during successive accesses to alternating memory banks. During accesses to the same memory bank multiple wait states will be inserted to guarantee RAS precharge.

If the user desires three wait states during successive accesses (an extra wait state per access), this can be accomplished by pulling WAITIN low during accesses. WAITIN should be programmed to add one clock period (CLKA) to the DTACK output. This will delay READY by one CLKA clock period.

If the user wants to do dual accessing with the DP8422A DRAM controller address buffers (74AS244s) must be added to the address, ECAS0-3, LOCK and WIN inputs. For the 32 MHz system (80386-16), the system diagram will remain unchanged, but the user will need to use the faster DP8422A-25 part.

For higher frequency dual access memory systems (above 32 MHz), design #2 will have to be modified as above. Also, CLKA should be inverted (use  $\overline{1Q}$  output from 74AS175). This will cause  $\overline{RAS}$  to be started one half CLKA clock period later, allowing extra address and chip select setup time to the DP8422A.

# **III. COMMON DESIGN FEATURES**

The logic shown in these applications form a complete 80386 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- a. arbitration between Port A, Port B, and refreshing the DRAM;
- b. the insertion of wait states to the processor (Port A) when needed (i.e., one wait state during address pipelined accesses (# 1 Designs), two wait states during non-address pipelined accesses (Design # 2), multiple wait states if an access takes place during a refresh operation or if RAS precharge is needed ... etc.);
- c. enabling address pipelining on the 80386 through the NA# input (#1 Designs only), and
- d. performing byte writes and reads to the 32-bit words in memory.

The timing calculations for two designs (Designs #1 and #2) are included in this application note with the DP8422A interfaced to the 80386-16 running at 32 MHz and the 80386-20 running at 40 MHz.

Since the DP8420A/21A/22A has a column address hold time of 32 ns the minimum time between two accesses (to guarantee 0 ns row address setup time) is 150 ns (equivalent to three clock periods at 20 MHz, 150 ns).

When using the DP8420A/21A/22A at 20 MHz the user should program three clock periods of precharge. This is because two clock periods of precharge at 20 MHz will only guarantee 81 ns of RAS precharge (2 x 50 ns <u>tp1</u>, (parameter #50 "14 ns") – clock (20 MHz) to AREQ high, (approximately 5 ns for both design #1 and #2)).

In Design #2A the four gates "A1, A2, B, C" are not necessary if the system designer already has some means of correctly enabling the data transceivers. Also, in Design #2A the NOR gate that produces READY will not be needed in many systems, the  $\overline{3Q}$  output of the 74AS175 could be used instead (READY2.5). Though, this output would not allow quite as much READY setup time as the output of the NOR gate.

Because of the way ALE is generated to the DP8422A, two pulses of ALE may be generated during each access (see timing diagrams 3, 4, 5, 8, 9 and 10). This is not detailed in the DP8420A/21A/22A data sheet but this is permissible as long as no glitches happen after AREQ transitions low for that access. Therefore, this is a valid way of providing ALE to the DP8422A.

| Programming<br>Bits | Description                                                                                              |
|---------------------|----------------------------------------------------------------------------------------------------------|
| R0 = 1              | RAS low four clocks, RAS precharge of three clocks                                                       |
| R1 = 1              |                                                                                                          |
| R2 = X              |                                                                                                          |
| R3 = X              |                                                                                                          |
| R4 = 0              | No WAIT states during burst accesses                                                                     |
| R5 = 0              |                                                                                                          |
| R6 = X              |                                                                                                          |
| R7 = X              |                                                                                                          |
| R8 = 0              | Interleaved Mode (requires DRAMs with a column address hold time of 32 ns or less)                       |
| R9 = X              |                                                                                                          |
| C0 = X              | Select based upon the input clock frequency. Example: if the input clock frequency is 16 MHz then choose |
| C1 = X              | C0, 1, $2 = 0$ , 1, 0 (divide by eight, this will give a frequency of 2 MHz).                            |
| C2 = X              |                                                                                                          |
| C3 = X              |                                                                                                          |
| C4 = 1              | RAS and CAS groups selected by "B1". This mode allows two RAS and two CAS outputs to go low during       |
| C5 = 0              | an access.                                                                                               |
| C6 = 1              |                                                                                                          |
| C7 = 1              | Column address setup time of 0 ns.                                                                       |
| C8 = 1              | Row address hold time of 15 ns.                                                                          |
| C9 = 1              | Delay $\overline{CAS}$ during write accesses to one clock after $\overline{RAS}$ transitions low         |
| B0 = 1              | Fall-thru latches                                                                                        |
| B1 = 0              | Access mode 0                                                                                            |
| ECAS0=0             | Non-extend CAS                                                                                           |
| 0 = Program wit     | th low voltage level                                                                                     |
| 1 = Program wit     | th high voltage level                                                                                    |
| X = Program wit     | th either high or low voltage level (don't care condition)                                               |

V. 80386 # 1 DESIGNS (AND # 2 DESIGN), 32 MHZ TIM-ING CALCULATIONS, WITH ONE WAIT STATE PER AC-CESS IN ADDRESS PIPELINED MODE, TWO WAIT STATES PER ACCESS IN NON-ADDRESS PIPELINED MODE (DP8422A-20 USES THE 16 MHZ CLOCK)

Note: Design #2 timing calculations are the same as Design #1 except for those calculations involving "CLKA", Timing calculations involving the minimum or maximum delay or skew of CLKA with respect to CLK2 should be recalculated substituting the 74AS175 parameters for the PAL parameters.

1. Maximum time to address valid (with respect to 16 MHz clock):

40 ns (maximum time to address valid) -2 ns ("D" speed PAL minimum delay, because 16 MHz clock is from PAL with minimum delay as skew from 32 MHz CPU clock) = 38 ns

2. Maximum time to ALE high (with respect to 16 MHz clock):

35 ns (maximum ADS valid) + 4.5 ns (74AS02 maximum

delay) -2 ns ("D" speed PAL minimum clock delay, for skew between 32 MHz and 16 MHz clock) = 37.5 ns The CLKA delay to ALE through 74AS02 is similar: 31 ns (one half clock period, 16 MHz) +4.5 ns (74AS02 maximum delay) + 1.5 ns (PAL estimated skew between low to high and high to low clock to output delay) = 37 ns

 Minimum ALE high setup time to CLKA high (DP8422A-20 needs 16 ns):

62.5 ns (one clock period, 16 MHz)-37.5 ns (#2) = 25 ns

4. Minimum address setup time to CLKA high (DP8422-20 needs 20 ns):

62.5 ns (Once clock period, 16 MHz) – 38 ns (#1) = 24.5 ns

5. Minimum CS setup time to CLKA high (DP8422-20 needs 14 ns):

24.5 ns (#4) -9 ns (74AS138 decoder) = 15.5 ns

| 6. Determining $t_{RAC}$ (RAS access time needed by the DRAM):                                                                                                                                                                                                                                                                                                                                                               | 2 |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|
| 250 ns (four clock periods at 16 MHz) $-62.5$ ns (one clock period) $-8$ ns (PALmaximum delay low to high from CLK2 clock, clock skew) $-10$ ns (data setup time) $-7$ ns (74AS245) $-32$ ns (CLK to RAS low) = 130.5 ns                                                                                                                                                                                                     |   |
| Therefore the $t_{\mbox{\scriptsize RAC}}$ of the DRAM must be 130.5 ns or less.                                                                                                                                                                                                                                                                                                                                             |   |
| 7. Determining $t_{\mbox{CAC}}$ (CAS access time needed by the DRAM):                                                                                                                                                                                                                                                                                                                                                        | 3 |
| 250 ns -62.5 ns -8 ns -10 ns -7 ns -89 ns (CLK to $\overline{\text{CAS}}$ low) = 73.5 ns                                                                                                                                                                                                                                                                                                                                     |   |
| Therefore the $t_{CAC}$ of the DRAM must be 73.5 ns or less. COMMON 120 ns DRAMS WILL MEET THIS $t_{RAC}$ AND $t_{CAC}$ PARAMETER.                                                                                                                                                                                                                                                                                           | 4 |
| 8. Minimum setup of DTACK0 to the PAL16R8D, DESIGN #1 ONLY, (need 10 ns):                                                                                                                                                                                                                                                                                                                                                    | ę |
| 62.5 ns (one clock period) -8 ns (PAL maximum delay<br>low to high from clock, clock skew 32 MHz vs 16 MHz)<br>-41 ns (clock to DTACK0 valid from DP8422A-20) =<br>13.5 ns                                                                                                                                                                                                                                                   |   |
| 9A. Minimum READY setup time to READY being sampled<br>(20 ns is needed by the 80386) DESIGN #1A and #1B:                                                                                                                                                                                                                                                                                                                    | ( |
| 31.25 ns (one half clock period) $-8$ ns (maximum "D" PAL clocked output delay) = 23.25 ns                                                                                                                                                                                                                                                                                                                                   |   |
| <ul><li>9B. Minimum READY setup time to READY being sampled<br/>(20 ns is needed by the 80386) DESIGN #2:</li></ul>                                                                                                                                                                                                                                                                                                          |   |
| IF 74AS02 IS USED TO PRODUCE READY:<br>31.25 ns (Last one half clock period of T2) + 13 ns<br>[17.5 ns (see in note below) $-4.5$ ns (max 74AS02 De-<br>lay)] = 44.25 ns                                                                                                                                                                                                                                                     | ī |
| IF $\overline{3Q}$ OUTPUT OF 74AS175 IS USED FOR READY:<br>31.25 ns (Last one half clock period of T2) - 10 ns (max<br>delay of 74AS175) = 21.25 ns                                                                                                                                                                                                                                                                          | 8 |
| Note: DTACK1.5 setup to 74AS175 input, used to generate DTACK2.5 (74AS175 needs 3 ns):                                                                                                                                                                                                                                                                                                                                       |   |
| 62.5 ns (one clock period at 16 MHz) -45 ns [7.5 ns<br>(CLKA max delay) + 33 ns (DP8422A-20 DTACK1.5<br>max delay) + 4.5 ns (74AS02 max delay)] = 17.5 ns                                                                                                                                                                                                                                                                    |   |
| setup to mid T2 of last access clock period.<br>10. Minimum NA setup time to NA being sampled, Design                                                                                                                                                                                                                                                                                                                        | ę |
| #1 only (10 ns is needed by the 80386):                                                                                                                                                                                                                                                                                                                                                                                      |   |
| 31 ns (one clock period at 32 MHz) $-8$ ns (maximum "D" PAL clocked output delay) = 23 ns                                                                                                                                                                                                                                                                                                                                    | 9 |
| VI. 80386 # 1 DESIGNS (AND # 2 DESIGN), 40 MHZ TIM-<br>ING CALCULATIONS, WITH ONE WAIT STATE PER AC-<br>CESS IN ADDRESS PIPELINED MODE, TWO WAIT<br>STATES PER ACCESS IN NON-ADDRESS PIPELINED<br>MODE (DP8422A-25 USES THE 20 MHZ CLOCK)                                                                                                                                                                                    |   |
| ***Note: Design #2 timing calculations are the same as Design #1 except<br>for those calculations involving "CLKA". CLKA is produced by a<br>74AS175 in Design #2 instead of a "D" speed PAL (Design #1).<br>Therefore the timing calculations involving the minimum or maxi-<br>mum delay or skew of CLKA with respect to CLK2 should be recal-<br>culated substituting the 74AS175 parameters for the PAL parame-<br>ters. | I |
| 1. Maximum time to address valid (with respect to 20 MHz clock):                                                                                                                                                                                                                                                                                                                                                             |   |
| 32 ns (maximum time to address valid) -2 ns ("D" speed<br>PAL minimum delay, because 20 MHz clock is from PAL<br>with minimum delay as skew from 40 MHz CPU clock) =<br>30 ns                                                                                                                                                                                                                                                |   |

2. Maximum time to ALE high (with respect to 20 MHz clock):

30 ns (maximum  $\overline{\text{ADS}}$  valid) +4.5 ns (74AS02 maximum delay) -2 ns (PAL minimum clock delay, for skew between 40 MHz and 20 MHz clock) = 32.5 ns

The CLKA delay to ALE through 74AS02 is: 25 ns (one half clock period, 20 MHz) +4.5 ns (74AS02 maximum delay) +1.5 ns (PAL skew between low to high and high to low clock to output delay) = 31 ns

3. Minimum ALE high setup time to CLKA high (DP8422A-25 needs 15 ns):

50 ns (one clock period, 20 MHz) -32.5 ns (#2) = 17.5 ns

4. Minimum address setup time to CLKA high (DP8422A-25 needs 18 ns):

50 ns (one clock period, 20 MHz) -30 ns (#1) = 20 ns

5. Minimum  $\overline{CS}$  setup time to CLKA high (DP8422A-25 needs 13 ns):

20 ns (#4) -6 ns (74AS139 two to four decoder) = 14 ns

6. Determining  $t_{\mbox{\scriptsize RAC}}$  (RAS access time needed by the DRAM):

200 ns (four clock periods at 20 MHz) -50 ns (one clock period) -8 ns (PAL maximum delay low to high from CLK2 clock, clock skew) -10 ns (data setup time) -7 ns (74AS245) -26 ns( CLK to RAS low) = 99 ns Therefore the t<sub>RAC</sub> of the DRAM must be 99 ns or less.

7. Determining t<sub>CAC</sub> (CAS access time needed by the DRAM):

200 ns -50 ns -8 ns -10 ns -7 ns -79 ns (CLK to  $\overline{\text{CAS}}$  Low) = 46 ns

Therefore the  $t_{\mbox{CAC}}$  of the DRAM must be 46 ns or less.

- 8. Minimum setup of DTACK0 to the PAL16R8D, DESIGN #1 ONLY, (need 8 ns):
  - 50 ns (one clock period) -8 ns (PAL maximum delay low to high from clock, clock skew 20 MHz vs 40 MHz) -33 ns (clock to DTACK0 valid from DP8422A-25) = 9 ns

9A. Minimum READY setup time to READY being sampled (11 ns is needed by the 80386) DESIGN #1:
 25 ns (one half clock period) −8 ns (maximum "D" PAL

clocked output delay) = 17 ns 9B. Minimum  $\overline{\text{READY}}$  setup time to  $\overline{\text{READY}}$  being sampled

(11 ns is needed by the 80386) DESIGN #2: IF 74AS02 IS USED TO PRODUCE READY:

(see in note below) -4.5 ns (max 74AS02 delay)] = 30.5 ns

IF  $\overline{30}$  OUTPUT OF 74AS175 IS USED FOR READY: 25 ns (Last one half clock period of T2) -10 ns (max delay of 74AS175) = 15 ns

Note: DTACK 1.5 setup to 74AS175 input, used to generate DTACK2.5 (74AS175 needs 3 ns):

50 ns (one clock period of 20 MHz) -40 ns [7.5 ns (CLKA max delay) +28 ns (DP8422-25 DTACK1.5 max delay) +4.5 ns (74AS02 max delay)] = 10 ns setup to mid T2 of last access clock period.

Minimum NA setup time to NA being sampled, Design #1 only (8 ns is needed by the 80386):

25 ns (one clock period at 40 MHz) -8 ns (maximum "D" PAL clocked output delay) = 17 ns

#### VII. 80386 DESIGN # 1. PAL EQUATIONS WRITTEN IN NATIONAL SEMICONDUCTOR PLAN™ FORMAT

DESIGN #1A UP TO 40 MHz (80386-20) PAL16R8D CLK2 82384CLK ADS CS DTACKO EXT\_NA W B1 RESET GND OF BOWE ADSID CLKA READ READY NA ADS3D BIWE VCC B1WE := ADS3D \* ADS1D \* READ \* DTACKO\*B1 +BIWE\*CLKA\*READ\*RESET BOWE := ADS3D \* ADS1D \* READ \* DTACKO \* B1 +BOWE\*CLKA\*READ\*RESET ADS3D := ADS1D \* CLKA \* RESET +ADS3D\*CLKA\*RESET NA := DTACKO\* ADS1D\* CLKA\*RESET\*W +DTACKO\*ADS1D\*ADS3D\*BOWE\*CLKA\*RESET +DTACKO\*ADS1D\*ADS3D\*B1WE\*CLKA\*RESET +EXT\_NA\*CLKA\*RESET +NA\*CLKA\*RESET READY := NA\* ADS3D \* ADS1D\* DTACKO\* CLKA\* RESET +READY\*ADS3D\*DTACKO\*RESET ADS1D := ADS \* CLKA \* CS +ADS1D\*NA\*RESET +ADS1D\*CLKA\*RESET READ := CS \* W \* ADS1D \* CLKA \* RESET +READ\*ADS1D\*RESET +READ\*CLKA\*RESET

#### CLKA := 82384CLK

DESIGN #1B UP TO 50 MHz (80386-25) PAL16R8D CLK2 82384CLK ADS CS RASO RAS2 W NO\_NA RESET GND OE BOWE ADSID CLKA READ READY NA ADS3D BIWE VCC

BIWE := ADS3D \* ADS1D \* READ \* RAS2 \* NO\_NA +B1WE\*CLKA\*READ\*RESET

BOWE := ADS3D \* ADS1D \* READ \* RAS0 \* NO\_NA +BOWE\*CLKA\*READ\*RESET

ADS3D := ADS1D \* CLKA \* RESET +ADS3D\*CLKA\*RESET

NA := RASO \* ADS1D \* CLKA \* RESET \* NO\_NA \* W +RASO\*ADS1D\*ADS3D\*BOWE\*CLKA\*RESET +RASO\*ADS1D\*ADS3D\*B1WE\*CLKA\*RESET +RAS2\*ADS1D\*CLKA\*RESET\*NO\_NA\*W +RAS2\*ADS1D\*ADS3D\*BOWE\*CLKA\*RESET +RAS2\*ADS1D\*ADS3D\*B1WE\*CLKA\*RESET +NA\*CLKA\*RESET

READY := NA\*ADS3D\*ADS1D\*RASO\*CLKA\*RESET\*NO\_NA +READY\*ADS3D\*RASO\*RESET\*NO\_NA +NA\*ADS3D\*ADS1D\*RAS2\*CLKA\*RESET\*NO\_NA +READY\*ADS3D\*RAS2\*RESET\*NO\_NA

ADS1D := ADS\*CLKA\*CS +ADS1D\*NA\*RESET +ADS1D\*CLKA\*RESET

READ := CS \* W \* ADS1D \* CLKA \* RESET +READ\*ADS1D\*RESET +READ\*CLKA\*RESET

CLKA := 82384CLK

Logic Needed for "NO\_\_NA" Term in Design #1B



# Key: Reading PAL Equations Written in PLAN

EXAMPLE EQUATIONS: READ:=CS\_RD\*ADS1D\*CIKA +READ\*ADS1D +READ\*CLKA

This example reads: the output "READ" will transition low on the next rising "CLK2" clock edge (given that one of the following conditions are valid, a setup time before "CLK2" transitions high);

- 1. the input "CS\_RD" is high AND the input "ADS1D" is high AND the input "CLKA" is low, OR
- 2. the output "READ" is low AND the input "ADS1D" is low, OR
- 3. the output "READ" is low AND the input "CLKA" is high

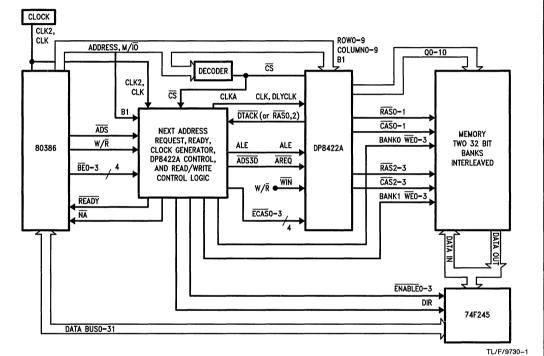
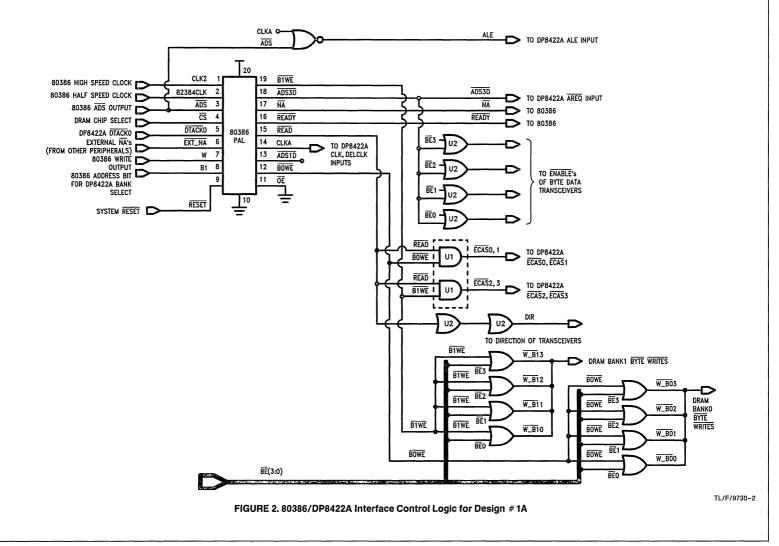
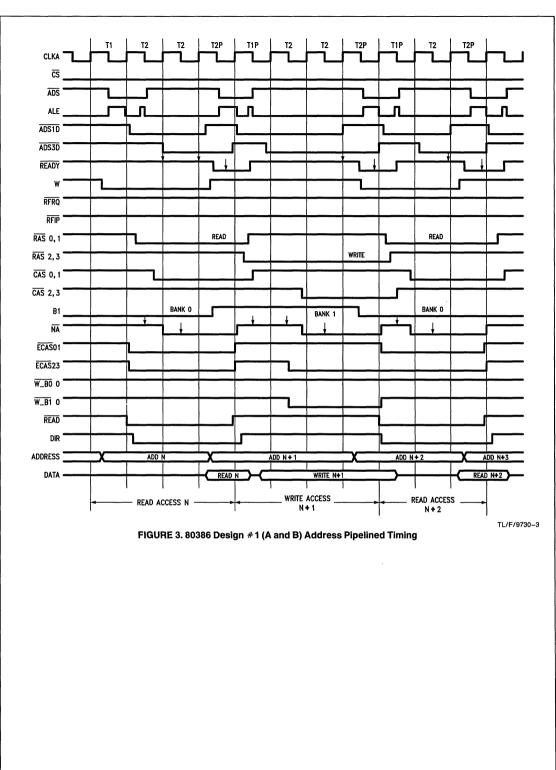


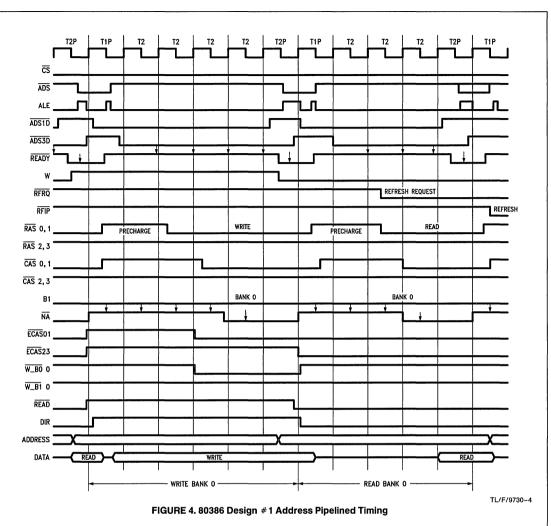
FIGURE 1. 80386 Design # 1 (A and B), System Block Diagram for Address Pipelined Mode Operation at up to 50 MHz (DP8422A Uses Half Speed Clock, CLKA)











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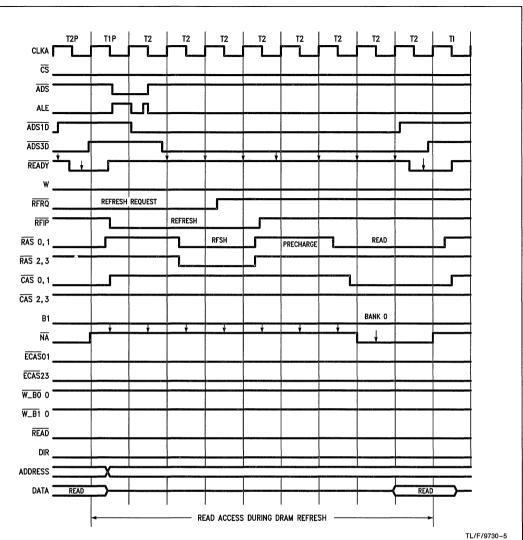
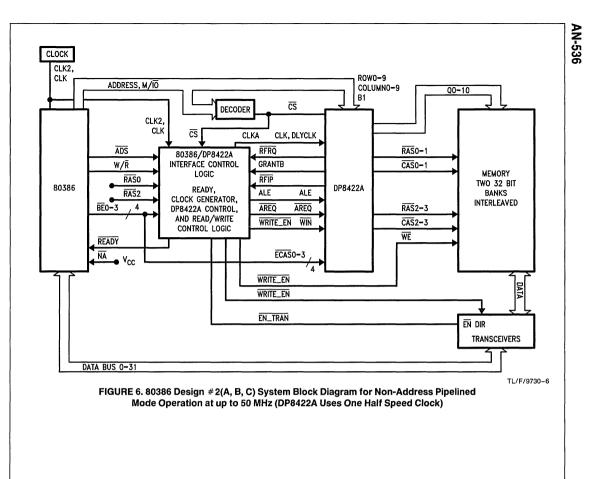
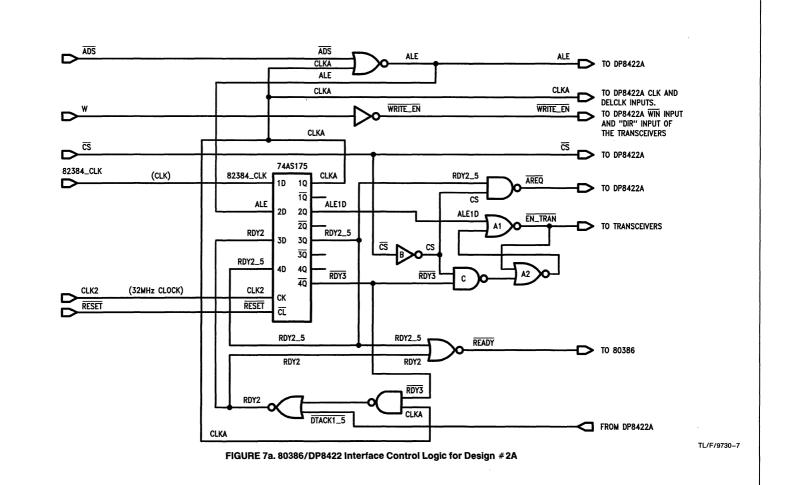


FIGURE 5. 80386 Design #1 Address Pipelined Timing



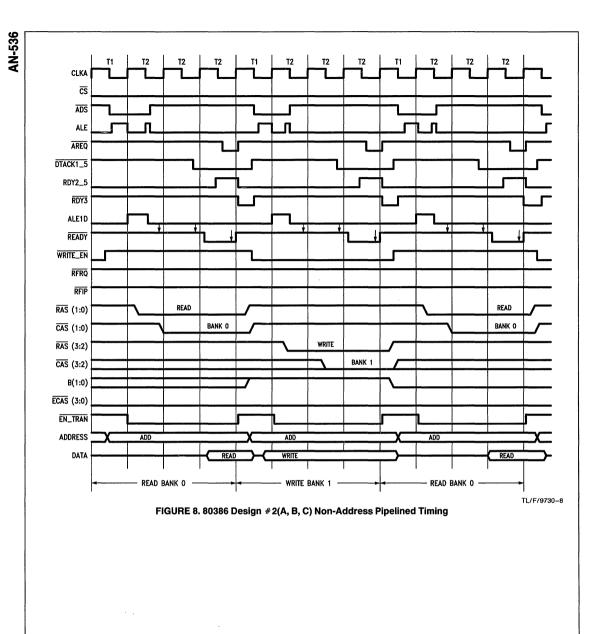


PAL16R4D CLK2 82384\_CLK CS~ ADS~ W DTACK1~ NC1 NC2 NC3 GND OE~ NC4 NC5 RDY\_D~ READY~ AREQ~ CLKA ALE WRITE\_EN~ VCC IF (VCC) WRITE\_EN~ = W \* /AREQ~ IF (VCC) ALE = /ADS~ \* /CLKA \* AREQ~ CLKA := /82384\_CLK AREQ~ := /CS~ \* ALE \* /CLKA + /AREQ~ \* /CS~ \* READY~ \* RDY\_D~ READY~ := /CS~ \* /AREQ~ \* /DTACK1~ \* RDY\_D~ \* /CLKA + /READY~ \* /CS~ \* /AREQ~ \* RDY\_D~ RDY\_D~ := /CS~ \* /AREQ~ \* /DTACK1~ \* /READY~ FIGURE 7B Design #2B: 80386 Non-Pipelined PAL (up to 20 MHz) PAL16R4E CLK2 82384\_CLK CS~ ADS~ W DTACK2~ NC1 NC2 NC3 GND OE~ NC4 READY~ RDY\_D~ NC5 AREQ~ CLKA ALE WRITE\_EN~ VCC IF (VCC) WRITE\_EN~ = W \* /AREQ~ IF (VCC) ALE = /ADS~ \* /CLKA \* AREQ~ IF (VCC) READY  $\sim$  = /CS  $\sim$  \* /AREQ  $\sim$  \* /DTACK2  $\sim$  \* RDY\_D  $\sim$  \* CLKA +/READY~ \* /CS~ \* /AREQ~ \* /CLKA CLKA := /82384\_CLK AREQ~ := /CS~ \* ALE \* /CLKA + /AREQ~ \* /CS~ \* READY~ \* RDY\_D~  $RDY_D \sim := /CS \sim * /AREQ \sim * /DTACK2 \sim * CLKA$ +/RDY\_D~ \* /READY~ \* /AREQ~ +/RDY\_D~ \* /CLKA

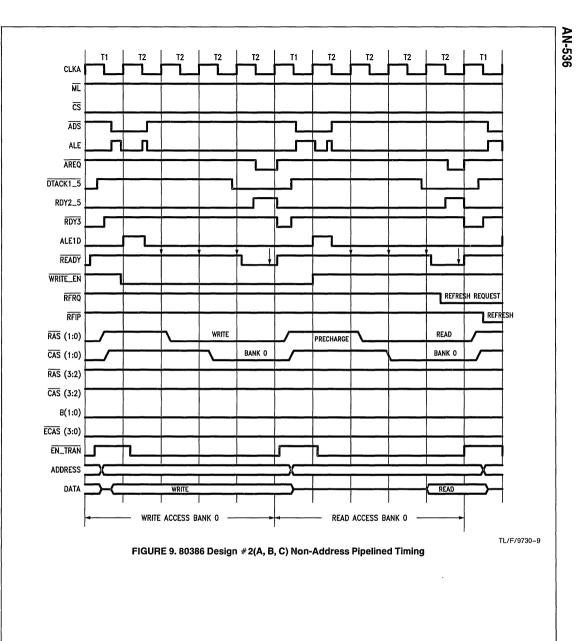
If the PAL design is used, the timing diagrams of *FIGURES 8, 9, 10* will be the same with the exception of AREQ which will look like the EN\_TRAN waveform. The AREQ output will drive EN\_TRAN. The meaning of AREQ ~ is the same AREQ.

FIGURE 7C. Design #2C: 80386 Non-pipelined PAL (up to 25 MHz. In this PAL design an external 74F74 Flip-Flop is used to capture 'DTACK1 $\sim$ ' which has a setup time of [40 ns-7.5 ns (CLKA delay) - 28 ns (DTACK1 $\sim$  delay) =] 4.5 ns. This 4.5 ns setup time is too small for any current PAL to capture. The captured 'DTACK1 $\sim$ ' is called 'DTACK2 $\sim$ ').

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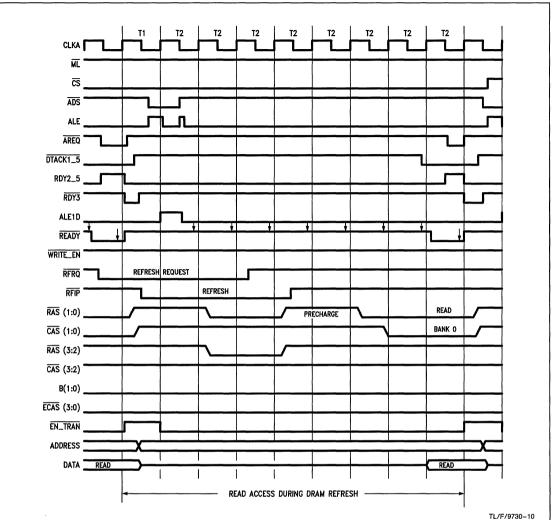
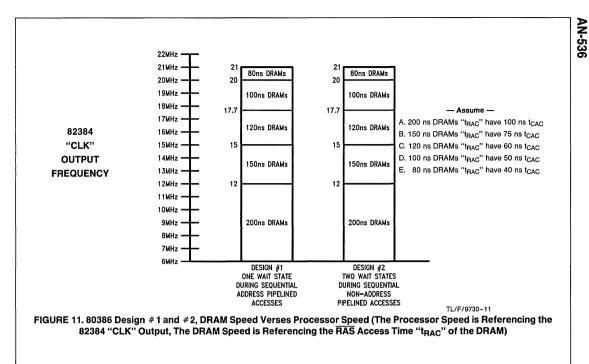


FIGURE 10. 80386 Design #2(A, B, C) Non-Address Pipelined Timing



## Interfacing the DP8420A/21A/22A to the 80386 (Zero Wait State Burst Mode Access)

### INTRODUCTION

This application note describes how to interface the 80386 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A) with burst mode access. The 80386 is running at 16 MHz, 20 MHz, or 25 MHz speed. It is assumed that the reader is familiar with the 80386 and DP8422A modes operation.

### DESCRIPTION

Two designs in this application note are provided to support page mode access in interfacing the DP8422A to the 80386 microprocessor. The DP8422A is operated in Mode 1 in both designs. An access cycle begins when the 80386 places a valid address on the address bus and asserts the Address Strobe (/ADS) if a refresh or Port B (DP8422A only) access is not in progress. During the burst access all /RAS's are kept low while toggling /CAS's. The burst access can be terminated when out of page signal is detected. The High Speed Access (/HSA) output signal of page detector (ALS6311) is used as an out of page signal to indicate whether the current access is in the same page as previous access or not. In other words, the row and bank select addresses have been changed from one access to the next.

#### I. Design #1 Description

This design simply consists of a DP8422A DRAM controller, a page detector (ALS6311), and two PALs (386PALN1 and 386PALN2). THE 386PALN1 is used to generate /CAS's and /WE signals. Where the 386PALN2 is to generate / ADS (or /AREQ), /NA, and /READY signals. This design can accommodate two banks of DRAM, 32 bits in each bank, giving a maximum memory capacity of 8 Mbytes (1M x 1 DRAMs) or 32 Mbytes (4M x 1 DRAMs). The schematic diagram is shown in *Figure 1*.

### II. Design #2 Description

This design consists of the DP8422A DRAM controller, a page detector (ALS6311), a count up and down counter (F169), two 20R4D PALs, and two 16R4D PALs. The count

### PROGRAMMING MODE BITS FOR DESIGN #1 AND #2

u = User Define x = Don't Care

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up and down counter is to hold the number of refresh being missed. The maximum missed refreshes are six to guarantee /RAS pulse width maximum timing ( $t_{RASP} = 100 \ \mu$ s). The external refresh control logic forces DRAM controller to initiate refresh as soon as the 80386 is not accessing the memory. 386PAL1 is used to generate /ECAS(3:0) and /BED(3:0) signals. 386PAL2 is to generate /ADS, /AREQ, /NA, and some intermediate signals. 386PAL3 is to generate /MOE, /RFSHCK, and /RFIPDn signals. 386PAL4 is to generate /WE, /READY, and some intermediate signals. The schematic diagram is shown in *Figure 5*. Two designs, based upon the load capacity, are described in the following:

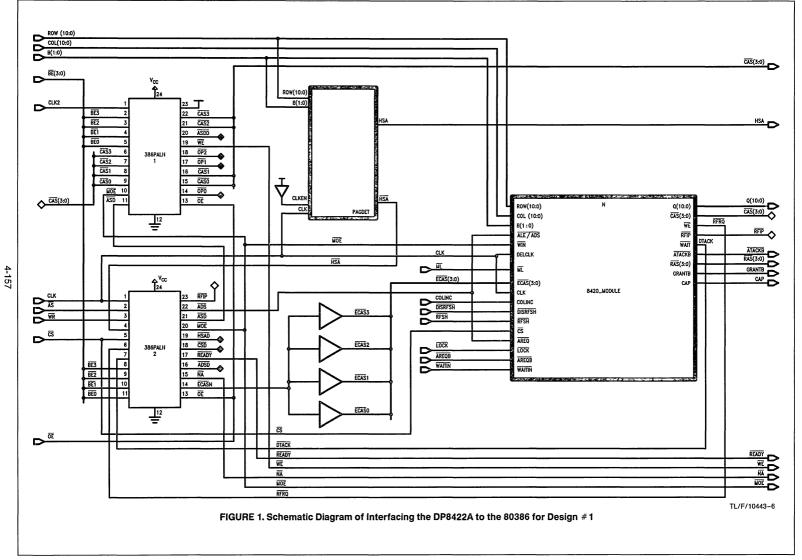
### A. Design #2 Description for Light Load

This design interface the DP8422A to the 80386 that can accommodate two banks of DRAM, each bank being 32 bits in width, giving a maximum memory capacity of 2 Mbytes (256k by 4 DRAM). During read or write burst access cycles, zero wait state can be achieved when the 80386 is running up to 25 MHz. /MOE is tied to /OE of DRAM for /OE controlled write access. Transceivers were eliminated in this design for gaining speed. During nonburst or initial access cycles that one, two, or three wait states are required depending upon the speed of the system clock.

### B. Design #2 Description for Heavy Load

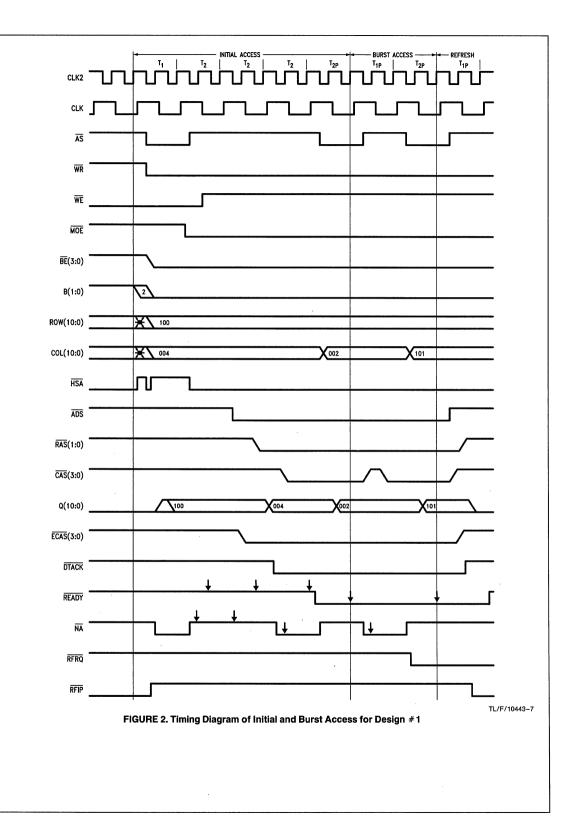
This design is to interface the DP8422A to the 80386 and up to 8 Mbytes (1 Mbits DRAM) or 32 Mbytes (4 Mbits DRAM) memory. Zero wait state can be achieved during read burst access cycle. During write burst access cycles, one wait state has to be inserted to the 80386 bus cycle in order to guarantee data valid before /CAS going low and column address hold time after /CAS going low. One, two, or three wait states are required for microprocessor to read or write valid data during nonburst or initial access cycles. The number of required wait states depends upon the speed of the system clock.

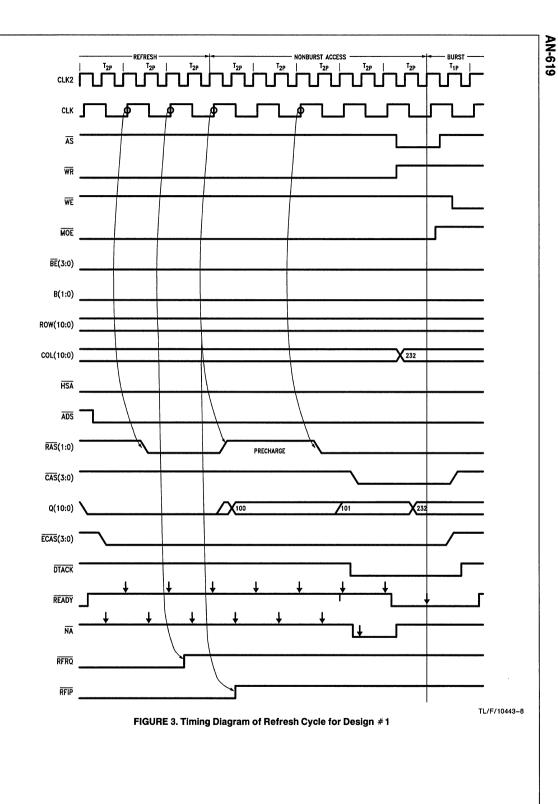
| Programming Bits |           | Description                                      |
|------------------|-----------|--------------------------------------------------|
| R9               | = u       | Stagger or /RAS Refresh                          |
| R8               | = 1       | Noninterleaved Mode                              |
| R7               | = 1       | /DTACK is selected                               |
| R6               | = x       | /WAITIN Controlled /DTACK High                   |
| R5, R4           | = 1, 1    | No Wait State during Burst Mode                  |
| R3, R2           | = u, u    | Wait State during Nonburst Mode                  |
| R1, R0           | = u, u    | /RAS Low and Precharge Time                      |
| C9               | = 0       | /CAS is same for READ & WRITE                    |
| C8, C7           | = 1, 1    | t <sub>RAH</sub> 15 ns and t <sub>ASC</sub> 0 ns |
| C6, C5, C4       | = u u, u  | /RAS and /CAS Configuration                      |
| C3               | = 0       | Refresh Clock Divider                            |
| C2, C1, C0       | = u, u, u | Refresh Clock Divisor Select                     |
| B1               | = 1       | Mode 1 Selected                                  |
| BO               | = 1       | Fall through Selected                            |
| /ECAS0           | = 1       | Extend /CAS and Refresh Request                  |



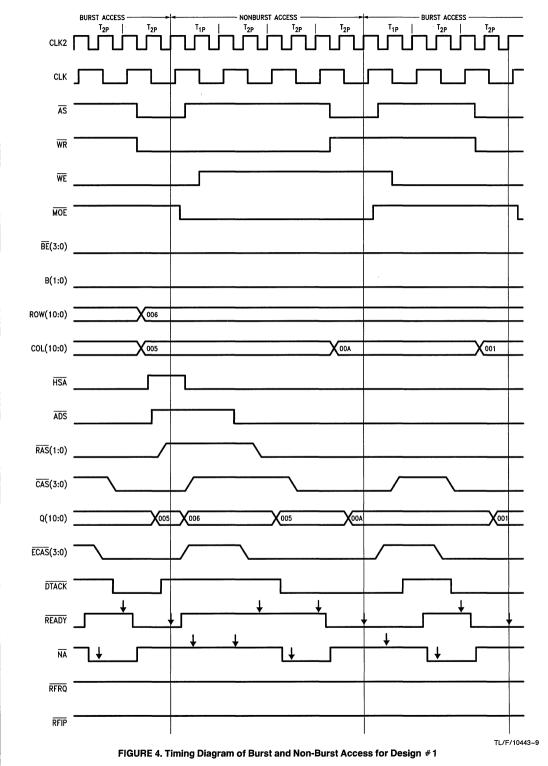


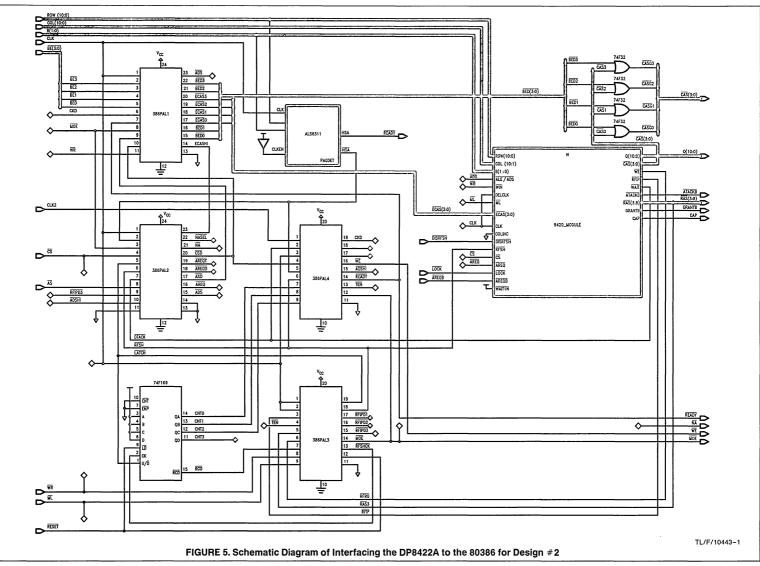






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### **DESIGN TIMING PARAMETERS**

AC timing parameters are referred to under the heavy load when using n M x 1 or n K x 1 DRAMs, and under light load when using n M x 4 or n K x 4 DRAMs.

Times that begin with a "\$" refer to DP8422A data sheet July 1988 and a "#" refer to Intel 1989 Microprocessor and Peripheral Handbook. The timing diagrams are shown in *Figure 2* through *Figure 4* and *Figure 6* through *Figure 9.* The simulation timing is based on 10 MHz clock. It may use E speed PAL for 25 MHz design.

I. Timing Calculation for Design #1 25 MHz t<sub>CP</sub> = 40 ns with light load \$400b: /ADS Asserted Setup to CLK t<sub>CP</sub> - PAL20R4E CLK t<sub>p</sub> max. - PAL20R4E t<sub>p</sub> max. = 40 ns - 7 ns - 8 ns = 25 ns(@ 25 MHz) \$401: /CS Setup to /ADS Asserted 2 t<sub>CP</sub> + PAL20R6E CLK t<sub>p</sub> min. + PAL20R6E tp min. - #6 Address Valid - Decoder tp max. = 80 ns + 4 ns + 6 ns - 21 ns - 9 ns $= 40 \, \text{ns}$ (@ 25 MHz) \$416: /AREQ Negated to /ADS Asserted 2  $t_{CP}$  + PAL20R6E CLK  $t_p$  min. + Skew of CLK2 and CLK min. - #6 Address Valid - /HSA t<sub>p</sub> max. = 80 ns + 4 ns + 3.5 ns - 21 ns - 14 ns = 52.5 ns (@ 25 MHz) a. Address pipelined burst mode access with 0 wait state: = 2 t<sub>CP</sub> - PAL20R4E t<sub>CLK</sub> max. - PAL20R4E <sup>t</sup>CAC tp max. - #21 (Data Setup) - 1/2 tCP - Skew of CLK2 and CLK max. - Transceiver tp max. = 80 ns - 7 ns - 8 ns - 7 ns - 20 ns - 10 ns - 6 ns = 22 ns (DP8422A-25 Part) = 3 t<sub>CP</sub> - \$26 (Address to Q Valid) - #6 tAA (Address Valid) - #21 (Data Setup) - Transceiver tp max. = 120 ns - 26 ns - 21 ns - 6 ns = 60 ns (DP8422A-25 Part) <sup>t</sup>OEA = 2 t<sub>CP</sub> - PAL20R6E CLK Out t<sub>p</sub> max. - #21 (Data Setup) - Transceiver tp max. = 80 ns - 7 ns - 11 ns - 6 ns = 56 ns (DP8422A-25 Part) b. Address pipelined nonburst mode access with 3 wait states and initial access with 4 wait states. = 4 t<sub>CP</sub> - PAL20R6E t<sub>CLK</sub> max. - PAL20R6E <sup>t</sup>RAC tp max. - \$402 (/ADS low to /RAS low) - #21 (Data Setup) - Skew of CLK2 and CLK tp max. Transceiver t<sub>p</sub> max. = 160 ns - 7 ns - 8 ns - 29 ns - 7 ns

= 160 ns - 7 ns - 8 ns - 29 ns - 7 ns - 10 ns - 6 ns

= 93 ns (DP8422A-25 Part)

#### = 4 t<sub>CP</sub> - PAL20R6E t<sub>CLK</sub> max. - PAL20R6E tCAC tp max. - \$403 (/ADS low to /CAS low) - #21 (Data Setup) - Skew of CLK2 and CLK tn max. - Transceiver tp max. = 160 ns - 7 ns - 8 ns - 82 ns - 7 ns- 10 ns - 6 ns = 40 ns (DP8422A-25 Part) t∆∆ = 4 t<sub>CP</sub> - PAL20R6E t<sub>CLK</sub> max. - PAL20R6E tp max. - \$417 (/ADS low to Column Address valid) - #21 (Data Setup) - Skew of CLK2 and CLK tp max. - Transceiver tp max. = 160 ns - 7 ns - 8 ns - 78 ns - 7 ns - 10 ns - 6 ns $= 44 \, \text{ns}$ (DP8422A-25 Part) = 5 t<sub>CP</sub> - PAL20R6E t<sub>CLK</sub> max. - #21 (Data tOEA Setup) - Skew CLK2 and CLK tp max. - Transceiver t<sub>p</sub> max. = 200 ns - 7 ns - 7 ns - 10 ns - 6 ns = 170 ns (DP8422A-25 Part) II. Timing Calculation for Design #2 \$400b: /ADS Asserted Setup to CLK t<sub>CP</sub> - PAL16R4D CLK t<sub>p</sub> max. - PAL20R4D t<sub>p</sub> max. = 62.5 ns - 8 ns - 10 ns = 44.5 ns (@ 16 MHz) = 50 ns - 8 ns - 10 ns = 32 ns(@ 20 MHz) = 40 ns - 8 ns - 10 ns = 22 ns (@ 25 MHz) \$401: /CS Setup to /ADS Asserted 3 t<sub>CP</sub> + PAL20R4D CLK t<sub>p</sub> min. + PAL20R4D t<sub>p</sub> min. - #6 Address Valid - Decoder t<sub>p</sub> max. = 187.5 ns + 5.5 ns + 7.1 ns - 36 ns - 9 ns = 155 ns (@ 16 MHz) = 150 ns + 5.5 ns + 7.1 ns - 30 ns - 9 ns = 123.6 ns (@ 20 MHz) = 120 ns + 5.5 ns + 7.1 ns - 21 ns - 9 ns = 102.6 ns (@ 25 MHz) \$416: /AREQ Negated to /ADS Asserted 2 t<sub>CP</sub> + PAL20R4D CLK t<sub>p</sub> min. + Skew of

# A. Design #2 Light Load Timing Calculation (No Transceivers):

1. 16 MHz t<sub>CP</sub> = 62.5 ns with light load

a. Address pipelined burst mode access with 0 wait state.

 $\begin{array}{rl} t_{CAC} & = 2 \ t_{CP} \ - \ PAL20R4D \ t_p \ max. \ - \ 74F32 \ t_p \ max. \\ & - \ \#21 \ (Data \ Setup) \ - \ 1/_2 \ t_{CP} \\ & = \ 125 \ ns \ - \ 10 \ ns \ - \ 6 \ ns \ - \ 11 \ ns \ - \ 31 \ ns \\ & = \ 67 \ ns \ \ \ (DP8422A-20 \ and \ DP8422A-25 \ Part) \end{array}$ 

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=3 t<sub>CP</sub> - \$26 (Address to Q Valid) - #6 t<sub>AA</sub> (Address Valid) - #21 (Data Setup) = 187.5 ns - 26 ns - 36 ns - 11 ns = 114.5 ns (DP8422A-25 Part) = 187.5 ns - 29 ns - 36 ns - 11 ns (DP8422A-20 Part) = 111.5 ns = 2 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> max. - #21 t<sub>OEA</sub> (Data Setup) = 125 ns - 8 ns - 11 ns = 106 ns (DP8422A-20 and DP8422A-25 Part) b. Address pipelined nonburst mode access with 2 wait states. = 3  $t_{CP}$  - \$307 (CLK High to /RAS Low) t<sub>RAC</sub> #21 (Data Setup) = 187.5 ns - 22 ns - 11 ns = 154 ns (DP8422A-25 Part) = 187.5 ns - 27 ns - 11 ns = 149.5 ns (DP8422A-20 Part) = 3  $t_{CP}$  - \$308 (CLK High to /CAS Low) tCAC #21 (Data Setup) - 74F32 tp max. = 187.5 ns - 72 ns - 11 ns - 6 ns = 98.5 ns (DP8422A-25 Part) = 187.5 ns - 81 ns - 11 ns - 6 ns = 89.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - \$316 (CLK High to Column Address tAA Valid) - #21 (Data Setup) = 187.5 ns - 66 ns - 11 ns = 110.5 ns (DP8422A-25 Part) = 187.5 ns - 78 ns - 11 ns = 98.5 ns (DP8422A-20 Part) = 4  $t_{CP}$  - PAL16R4D CLK out  $t_p$  max. - #21 tOEA (Data Setup) = 250 ns - 8 ns - 11 ns = 231 ns (DP8422A-20 and DP8422A-25 Part) c. Initial Access with 3 Wait States. = 3 t<sub>CP</sub> - PAL20R4D CLK t<sub>n</sub> max. - \$402 t<sub>RAC</sub> (/ADS Low to /RAS Low) - #21 (Data Setup) = 187.5 ns - 8 ns - 25 ns - 11 ns (DP8422A-25 Part) = 143.5 ns = 187.5 ns - 8 ns - 30 ns - 11 ns = 138.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - PAL20R4D CLK t<sub>p</sub> max. - \$403 tCAC (/ADS Low to /CAS Low) - #21 (Data Setup) - 74F32 t<sub>p</sub> Max. = 187.5 ns - 8 ns - 75 ns - 11 ns - 6 ns = 87.5 ns (DP8422A-25 Part) = 187.5 ns - 8 ns - 86 ns - 11 ns - 6 ns = 76.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - PAL20R4D CLK t<sub>p</sub> max. - \$417 t<sub>AA</sub> (/ADS Low to Column Address Valid) #21 (Data Setup) = 187.5 ns - 8 ns - 69 ns - 11 ns (DP8422A-25 Part) = 99.5 ns = 187.5 ns - 8 ns - 83 ns - 11 ns = 85.5 ns (DP8422A-20 Part)

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= 3 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> max. - #21 **t**OEA (Data Setup) = 187.5 ns - 8 ns -11 ns = 168.5 ns (DP8422A-20 and DP8422A-25 Part) 2. 20 MHz t<sub>CP</sub> = 50 ns with light load a. Address pipelined burst mode access with 0 wait state.  $= 2 t_{CP} - PAL20R4D t_{p} max.$ tCAC - 74F32 tn max. - #21 (Data Setup) -1/2 tcp. = 100 ns - 10 ns - 6 ns - 11 ns - 25 ns (DP8422A-20 and DP8422A-25 Part) = 48 ns = 3 t<sub>CP</sub> - \$26 (Address to Q Valid) - #6 t<sub>AA</sub> (Address Valid) - #21 (Data Setup) = 150 ns - 26 ns - 30 ns - 11 ns = 83 ns (DP8422A-25 Part) = 150 ns - 29 ns - 30 ns - 11 ns = 80 ns (DP8422A-20 Part) = 2 t<sub>CP</sub> - PAL16R4D CLK out t<sub>p</sub> max **tOEA** #21 (Data Setup) = 100 ns - 8 ns - 11 ns = 81 ns (DP8422A-20 and DP8422A-25 Part) b. Address pipelined nonburst mode access with 2 wait states. = 3  $t_{CP}$  - \$307 (CLK High to /RAS Low) t<sub>RAC</sub> #21 (Data Setup) = 150 ns - 22 ns - 11 ns = 117 ns (DP8422A-25 Part) = 150 ns - 27 ns - 11 ns  $= 112 \, \text{ns}$ (DP8422A-20 Part) = 3  $t_{CP}$  - \$308 (CLK High to /CAS Low) tCAC #21 (Data Setup) - 74F32 tp max. = 150 ns - 72 ns - 11 ns - 6 ns = 61 ns (DP8422A-25 Part) = 150 ns - 81 ns - 11 ns - 6 ns = 52 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - \$316 (CLK High to Column Address t<sub>AA</sub> Valid) - #21 (Data Setup) = 150 ns - 66 ns - 11 ns = 73 ns (DP8422A-25 Part) = 150 ns - 78 ns - 11 ns (DP8422A-20 Part) = 61 ns = 4 t<sub>CP</sub> - PAL16R4D CLK out t<sub>p</sub> max. - #21 **t**OEA (Data Setup) = 200 ns - 8 ns - 11 ns = 181 ns (DP8422A-20 and DP8422A-25 Part) c. Initial access with 3 wait states. = 3 t<sub>CP</sub> - PAL20R4D CLK t<sub>p</sub> max. - \$402 **t**RAC (/ADS Low to /RAS Low) - #21 (Data Setup) = 150 ns - 8 ns - 25 ns - 11 ns = 106 ns (DP8422A-25 Part) = 150 ns - 8 ns - 30 ns - 11 ns

| <sup>t</sup> CAC      | = 3 t <sub>CP</sub> - PAL20R4D CLK t <sub>p</sub> max \$403<br>(/ADS Low to /CAS Low) - #21 (Data |
|-----------------------|---------------------------------------------------------------------------------------------------|
|                       | Setup) – 74F32 t <sub>p</sub> max.                                                                |
|                       | = 150  ns - 8  ns - 75  ns - 11  ns - 6  ns                                                       |
|                       | = 50 ns (DP8422A-25 Part)                                                                         |
|                       | = 150 ns - 8 ns - 86 ns - 11 ns - 6 ns                                                            |
|                       | = 39 ns (DP8422A-20 Part)                                                                         |
| t <sub>AA</sub>       | = 3 t <sub>CP</sub> - PAL20R4D CLK t <sub>p</sub> max. \$417 (/ADS                                |
|                       | Low to Column Address Valid) #21 (Data<br>Setup)                                                  |
|                       | = 150 ns - 8 ns - 69 ns - 11 ns                                                                   |
|                       | = 62 ns (DP8422A-25 Part)                                                                         |
|                       | = 150 ns - 8 ns - 83 ns - 11 ns                                                                   |
|                       | = 48 ns (DP8422A-20 Part)                                                                         |
| <sup>t</sup> OEA      | = 3 t <sub>CP</sub> - PAL16R4D CLK Out t <sub>p</sub> max #21<br>(Data Setup)                     |
|                       | = 150 ns - 8 ns - 11 ns                                                                           |
|                       | = 131 ns (DP8422A-20 and DP8422A-25 Part)                                                         |
| 3. 25 MHz             | $t_{CP} = 40$ ns with light load                                                                  |
| a. Addres:            | s pipelined burst mode access with 0 wait state.                                                  |
| tCAC                  | = 2 t <sub>CP</sub> - PAL20R4D t <sub>p</sub> max.                                                |
|                       | - 74F32 t <sub>p</sub> max #21 (Data Setup) -<br>½ t <sub>CP</sub> .                              |
|                       | = 80  ns - 10  ns - 6  ns - 7  ns - 20  ns                                                        |
|                       | = 37 ns (DP8422A-25 Part)                                                                         |
| t <sub>AA</sub>       | = 3 t <sub>CP</sub> $-$ \$26 (Address to Q Valid) $-$ #6                                          |
|                       | (Address Valid) - #21 (Data Setup)                                                                |
|                       | = 120 ns - 26 ns - 21 ns - 7 ns                                                                   |
|                       | = 83 ns (DP8422A-25 Part)                                                                         |
| <sup>t</sup> OEA      | = 2 t <sub>CP</sub> - PAL16R4D CLK Out t <sub>p</sub> max #21<br>(Data Setup)                     |
|                       | = 80 ns - 8 ns - 11 ns                                                                            |
|                       | = 65 ns (DP8422A-25 Part)                                                                         |
| b. Address<br>states. | s pipelined nonburst mode access with 2 wait                                                      |
| <sup>t</sup> RAC      | = 3 t <sub>CP</sub> - \$307 (CLK High to /RAS Low) - #21 (Data Setup)                             |
|                       | = 120 ns - 22 ns - 7 ns                                                                           |
|                       | = 91 ns (DP8422A-25 Part)                                                                         |
| tCAC                  | = 3 t <sub>CP</sub> $-$ \$308 (CLK High to /CAS Low) $-$                                          |
|                       | #21 (Data Setup) — 74F32 t <sub>p</sub> max.                                                      |
|                       | = 120 ns - 72 ns - 7 ns - 6 ns                                                                    |
|                       | = 35 ns (DP8422A-25 Part)                                                                         |
| t <sub>AA</sub>       | = 3 t <sub>CP</sub> $-$ \$316 (CLK High to Column Address                                         |
|                       | Valid) – #21 (Data Setup)                                                                         |
|                       | = 120 ns - 66 ns - 7 ns                                                                           |
|                       | = 47 ns (DP8422A-25 Part)                                                                         |
| <sup>t</sup> OEA      | = 4 $t_{CP}$ - PAL16R4D CLK Out $t_p$ max #21                                                     |
|                       | (Data Setup)                                                                                      |
|                       | = 160  ns - 8  ns - 7  ns                                                                         |
|                       | = 145 ns (DP8422A-25 Part)                                                                        |
| c. Initial a          | ccess with 4 wait states.                                                                         |
| <sup>t</sup> RAC      | = 4 $t_{CP}$ - PAL20R4D CLK $t_p$ max \$402                                                       |
|                       | (/ADS Low to /RAS Low) - #21 (Data                                                                |
|                       | Setup)                                                                                            |
|                       | = 160  ns - 8  ns - 25  ns - 7  ns<br>= 120 ns (DP8422A 25 Part)                                  |
|                       | = 120 ns (DP8422A-25 Part)                                                                        |
|                       |                                                                                                   |

= 4 t<sub>CP</sub> - PAL20R4D CLK t<sub>p</sub> max. - \$403 tCAC (/ADS Low to /CAS Low) - #21 (Data Setup) - 74F32 tp max. = 160 ns - 8 ns - 75 ns - 7 ns - 6 ns = 64 ns (DP8422A-25 Part) = 4 t<sub>CP</sub> - PAL20R4D CLK t<sub>p</sub> max. - \$417 t<sub>AA</sub> (/ADS Low to Column Address Valid ) -#21 (Data Setup) = 160 ns - 8 ns - 69 ns - 7 ns (DP8422A-25 Part) = 76 ns = 4 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> max. - #21 t<sub>OEA</sub> (Data Setup) = 160 ns - 8 ns - 7 ns = 145 ns (DP8422A-25 Part) B. Design #2 Heavy Load Timing Calculation: 1. 16 MHz t<sub>CP</sub> = 62.5 ns with Heavy Load a. Address pipelined burst mode access with 0 wait state. = 2 t<sub>CP</sub> - PAL20R4D t<sub>p</sub> max. - 74F32 t<sub>p</sub> max. tCAC - #21 (Data Setup) - 1/2 t<sub>CP</sub> Transceiver tn max. = 125 ns - 10 ns - 8 ns - 11 ns - 31 ns -7 ns = 48 ns (DP8422A-20 and DP8422A-25 Part) = 3 t<sub>CP</sub> - \$26 (Address to Q Valid) - #6 tAA (Address Valid) - #21 (Data Setup) -Transceiver tp max. = 187.5 ns - 35 ns - 36 ns - 11 ns - 7 ns = 98.5 ns (DP8422A-25 Part) = 187.5 ns - 38 ns - 36 ns - 11 ns - 7 ns = 95.5 ns (DP8422A-20 Part) = 2 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> Max. - #21 tOFA (Data Setup) - Transceiver to max. = 125 ns - 8 ns - 11 ns - 7 ns = 89 ns (DP8422A-20 and DP8422A-25 Part) b. Address pipelined nonburst mode access with 2 wait states. t<sub>RAC</sub> = 3 t<sub>CP</sub> - \$307 (CLK High to /RAS Low) -#21 (Data Setup) - Transceiver tp max. = 187.5 ns - 26 ns - 11 ns - 7 ns = 143.5 ns (DP8422A-25 Part) = 187.5 ns - 32 ns - 11 ns - 7 ns = 137.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - \$308 (CLK High to /CAS Low) tCAC #21 (Data Setup) - 74F32 tp max. -Transceiver tp max. = 187.5 ns - 72 ns - 11 ns - 8 ns - 7 ns = 89.5 ns (DP8422A-25 Part) = 187.5 ns - 81 ns - 11 ns - 8 ns - 7 ns = 80.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - \$316 (CLK High to Column Address t<sub>AA</sub> Valid) - #21 (Data Setup) - Transceiver tn max. = 187.5 ns - 75 ns - 11 ns - 7 ns = 94.5 ns (DP8422A-25 Part) = 187.5 ns - 87 ns - 11 ns - 7 ns = 82.5 ns (DP8422A-20 Part)

t<sub>OEA</sub> = 4 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> max. -#21 (Data Setup) - Transceiver tn max. = 250 ns - 8 ns - 11 ns - 7 ns = 224 ns (DP8422A-20 and DP8422A-25 Part) c. Initial Access with 3 Wait States. = 3 t<sub>CP</sub> - PAL20R4D CLK t<sub>p</sub> max. - \$402 t<sub>RAC</sub> (/ADS Low to /RAS Low) - #21 (Data Setup) - Transceiver tn max. = 187.5 ns - 8 ns - 29 ns - 11 ns - 7 ns = 132.5 ns (DP8422A-25 Part) = 187.5 ns - 8 ns - 35 ns - 11 ns - 7 ns = 126.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - PAL20R4D CLK t<sub>p</sub> max. - 403tCAC (/ADS Low to /CAS Low) - #21 (Data Setup) - 74F32 tp max. - Transceiver tp max. = 187.5 ns - 8 ns - 75 ns - 11 ns - 8 ns -7 ns = 78.5 ns (DP8422A-25 Part) = 187.5 ns - 8 ns - 86 ns - 11 ns - 8 ns -7 ns = 67.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - PAL20R4D CLK t<sub>n</sub> max. - \$417 t<sub>AA</sub> (/ADS Low to Column Address Valid) -#21 (Data Setup) - Transceiver tp max. = 187.5 ns - 8 ns - 78 ns - 11 ns - 7 ns = 83.5 ns (DP8422A-25 Part) = 187.5 ns - 8 ns - 92 ns - 11 ns - 7 ns = 69.5 ns (DP8422A-20 Part) = 3 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> max. - #21 <sup>t</sup>OEA (Data Setup) - Transceiver tp max. = 187.5 ns - 8 ns - 11 ns - 7 ns = 161.5 ns (DP8422A-20 and DP8422A-25 Part) 2. 20 MHz t<sub>CP</sub> = 50 ns with heavy load a. Address pipelined burst mode access with 0 wait state. = 2  $t_{CP}$  - PAL20R4D  $t_p$  max. - 74F32  $t_p$  max. t<sub>CAC</sub> - #21 (Data Setup) - 1/2 t<sub>CP</sub> - Transceiver tn max. = 100 ns - 10 ns - 8 ns - 11 ns - 25 ns -7 ns (DP8422A-20 and DP8422A-25 Part)  $= 29 \, \text{ns}$ = 3  $t_{CP}$  - \$26 (Address to Q Valid) - #6 t<sub>AA</sub> (Address Valid) - #21 (Data Setup) -Transceiver t<sub>p</sub> max. = 150 ns - 35 ns - 30 ns - 11 ns - 7 ns = 67 ns (DP8422A-25 Part) = 150 ns - 38 ns - 30 ns - 11 ns - 7 ns = 64 ns (DP8422A-20 Part) = 2 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> max. - #21 t<sub>OEA</sub> (Data Setup) - Transceiver tp max. = 100 ns - 8 ns - 11 ns - 7 ns = 74 ns (DP8422A-20 and DP8422A-25 Part)

b. Address pipelined nonburst mode access with 2 wait states  $t_{RAC}~=$  3 t\_{CP} - \$307 (CLK High to /RAS Low) -

#21 (Data Setup) - Transceiver  $t_p$  max. = 150 ns - 26 ns - 11 ns - 7 ns

= 106 ns (DP8422A-25 Part)

= 150 ns - 32 ns - 11 ns - 7 ns

= 100 ns (DP8422A-20 Part)

t<sub>CAC</sub> = 3 t<sub>CP</sub> − \$308 (CLK High to /CAS Low) − #21 (Data Setup) − 74F32 t<sub>p</sub> max. − Transceiver t<sub>p</sub> max. = 150 ns − 72 ns − 11 ns − 8 ns − 7 ns

= 52 ns (DP8422A-25 Part) = 150 ns - 81 ns - 11 ns - 8 ns - 7 ns

 $\begin{array}{r} = 130 \text{ Hs} & \text{OHS} & \text{OHS} & \text{OHS} & \text{OHS} \\ = 43 \text{ ns} & (\text{DP8422A-20 Part}) \\ t_{\text{AA}} & = 3 t_{\text{CP}} - \$316 \text{ (CL High to Column Address} \\ & \text{Valid}) - \#21 \text{ (Data Setup)} - \text{Transceiver} \end{array}$ 

= 150 ns - 87 ns - 11 ns - 7 ns= 45 ns (DP8422A-20 Part)

t<sub>OEA</sub> = 4 t<sub>CP</sub> - PAL16R4D CLK Out t<sub>p</sub> max. -#21 (Data Setup) - Transceiver t<sub>p</sub> max. = 200 ns - 8 ns - 11 ns - 7 ns

= 174 ns (DP8422A-20 and DP8422A-25 Part)

c. Initial access with 4 wait states.

$$\begin{split} t_{RAC} &= 4 \ t_{CP} - \text{PAL20R4D CLK } t_p \ \text{max.} - \$402 \\ & (/\text{ADS Low to /RAS Low}) - \#21 \ (\text{Data} \\ & \text{Setup}) - \text{Transceiver } t_p \ \text{max.} \\ &= 200 \ \text{ns} - 8 \ \text{ns} - 29 \ \text{ns} - 11 \ \text{ns} - 7 \ \text{ns} \\ &= 145 \ \text{ns} \qquad (\text{DP8422A-25 Part}) \\ &= 200 \ \text{ns} - 8 \ \text{ns} - 35 \ \text{ns} - 11 \ \text{ns} - 7 \ \text{ns} \\ &= 139 \ \text{ns} \qquad (\text{DP8422A-20 Part}) \\ & t_{CAC} &= 4 \ t_{CP} - \text{PAL20R4D CLK } t_p \ \text{max.} - \$403 \end{split}$$

$$(ADS Low to /CAS Low) - #21 (DataSetup) - 74F32 tp max. -Transceiver tp max.= 200 ns - 8 ns - 75 ns - 11 ns - 8 ns -7 ns= 91 ns (DP8422A-25 Part)= 200 ns - 8 ns - 86 ns - 11 ns - 8 ns -$$

= 200 ns - 8 ns - 86 ns - 11 ns - 8 ns -7 ns

= 80 ns (DP8422A-20 Part)

- OEA = 4 t<sub>CP</sub> PAL16H4D CLK Out t<sub>p</sub> max. -#21 (Data Setup) - Transceiver t<sub>p</sub> max. = 200 ns - 8 ns - 11 ns - 7 ns = 174 ns (DP8422A-20 and DP8422A-25 Part)

### PAL EQUATIONS

| PAL EQUATIONS                                                                                           |                                                                                                                                          |  |  |
|---------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| The Boolea                                                                                              | The Boolean entry operators are listed as:                                                                                               |  |  |
|                                                                                                         | "=" Equality                                                                                                                             |  |  |
| ":=" Replaced by (After Clock)                                                                          |                                                                                                                                          |  |  |
| "*" ANE                                                                                                 | )                                                                                                                                        |  |  |
| "+" OR                                                                                                  |                                                                                                                                          |  |  |
| , .                                                                                                     | nplement<br>ve Low                                                                                                                       |  |  |
| 1                                                                                                       |                                                                                                                                          |  |  |
| The brief explanation of PAL output signals<br>CAS(3:0) ~ These combinational output signals are Column |                                                                                                                                          |  |  |
|                                                                                                         | Address Strobes                                                                                                                          |  |  |
| ASDD~                                                                                                   | This sequential output signal is ASD~ Delayed by one CLK2 clock.                                                                         |  |  |
| HSAD~                                                                                                   | This sequential output signal is ${\rm HSA}\sim{\rm Delayed}$ by one clock.                                                              |  |  |
| ADSD~                                                                                                   | This sequential output signal is $ADS \sim Delayed$ by one clock.                                                                        |  |  |
| BED(3:0)~                                                                                               | These combinational output signals are used to toggle CAS of DRAM directly during burst and nonburst access cycles.                      |  |  |
| ECAS~(3:0)                                                                                              | These sequential output signals are used to hold CAS low during the burst access except design #2 heavy load burst write access cycles.  |  |  |
| ADS~                                                                                                    | This combinational output signal is Address Strobe to the DP8422A.                                                                       |  |  |
| AREQ~                                                                                                   | This combinational output signal is Access Request to the DP8422A.                                                                       |  |  |
| NASEL~                                                                                                  | This combinational output signal selects Next<br>Address from either initial or noninitial access<br>cycles.                             |  |  |
| NA~                                                                                                     | This combinational output signal is Next Address to the 80386.                                                                           |  |  |
| CSD~                                                                                                    | This sequential output signal is Chip Select De-<br>layed by one clock.                                                                  |  |  |
| AREQT~                                                                                                  | This sequential output signal is Access Request Transition that holds HSA $\sim$ (High Speed Access) one clock during CSD $\sim$ is low. |  |  |
| AREQD~                                                                                                  | This sequential output signal is Access Request Delayed by one clock.                                                                    |  |  |
| ASD~                                                                                                    | This sequential output signal is Address Strobe Delayed by one clock.                                                                    |  |  |
| WE~                                                                                                     | This combinational output signal is Write Enable to the DRAM.                                                                            |  |  |
| LATCH~                                                                                                  | This combinational output signal is to hold ex-<br>ternal refresh request.                                                               |  |  |
| RFSH~                                                                                                   | This combinational output signal is complement of LATCH $\sim$ .                                                                         |  |  |
| RFSHCK~                                                                                                 | This combinational output signal is used to clock count up and down counter.                                                             |  |  |
| RFIPD1~                                                                                                 | This sequential output signal is Refresh In Prog-<br>ress Delayed by one clock.                                                          |  |  |
| RFIPD2~                                                                                                 | This sequential output signal is Refresh In Prog-<br>ress Delayed by two clocks.                                                         |  |  |
| RFIPD3~                                                                                                 | This sequential output signal is Refresh in Prog-<br>ress Delayed by three clocks.                                                       |  |  |
|                                                                                                         |                                                                                                                                          |  |  |
|                                                                                                         |                                                                                                                                          |  |  |

| ∕IOE∼ | This sequential output signal is Memory Output |
|-------|------------------------------------------------|
|       | Enable to control the data output of the DRAM. |

- TEN~ This combinational output signal indicates that six missed refreshes are reached.
- CKD This combinational output signal is normal CLK delayed by PAL.
- ADSHI~ This sequential output signal indicates whether the 80386 is accessing the DRAM or the DP8422A is refreshing the DRAM.

### Ia. 386PALN1 (PAL20R4E) for Design #1

Inputs: CLK2, BE3~, BE2~, BE1~, BE0~, CAS~3, CAS~2, CAS~1, CAS~0, MOE~, ASD~;

Outputs:

N

- /CAS3~ = (/ASDD~ \* /CAS~3) + (ASD~ \* /CAS~3) + (MOE~ \* /CAS~3) + (BE3~ \* /CAS~3);
- /CAS2~ = (/ASDD~ \* /CAS~2) + (ASD~ \* /CAS~2) + MOE~ \* /CAS~2) + (BE2~ \* /CAS~2);
- /CAS1~ = (/ASDD~ \* /CAS~1) + (ASD~ \* /CAS~1) + MOE~ \* /CAS~1) + (BE1~ \* /CAS~1);
- $/CASO \sim = (/ASDD \sim * /CAS \sim 0) + (ASD \sim * /CAS \sim 0) + MOE \sim * /CAS \sim 0) + (BEO \sim * /CAS \sim 0);$  $/ASDD \sim := /ASD \sim :$

### Ib. 386PALN2 (PAL20R6E) for Design # 1

Inputs: CLK, BE3~, BE2~, BE1~, BE0~, CS~, HSA~, RFRQ~, RFIP~, DTACK~, AS~, WR~;

Outputs: /ADS~ = (/HSAD~ \* RFRQ~ \* /HHA~) + (ASD~ \* /RFRQ~); /NA~ = (READY~ \* /DTACK~ \* RFRQ~ \* RFIP~) + (READY~ \* MOE~ \* RFRQ~ \* RFIP~) + (/READY~ \* RFRQ~ \* /MOE~ \* /ASD~  $RFIP \sim$ );  $/ECAS \sim N = (ASD \sim * /HSAD \sim * RFRQ \sim) +$ (BE3~ \* BE2~ \* BE1~ \* BE0~ \* /HSAD~ \* RFRQ~) + (/MOE~ \* /HSAD~ \* RFRQ~) + (CSD~ \* /HSAD~ \* RFRQ~) + (ASD~ \*  $/RFRQ \sim$ ); /CSD~ := /CS~; /ASD~ := /AS~: /MOE~ := /WR~; := /HSA~ \* /CSD~; /HSAD~  $/READY \sim := /DTACK \sim;$ /ADSD~ := /ADS~; II a. 386PAL1 (PAL20R4D) for Design #2 Light Load

Inputs: CLK, BE3~, BE2~, BE1~, BE0~, READY~, CKD, MOE~, ASD~, CSD~, WR~, ADS~;

Outputs:

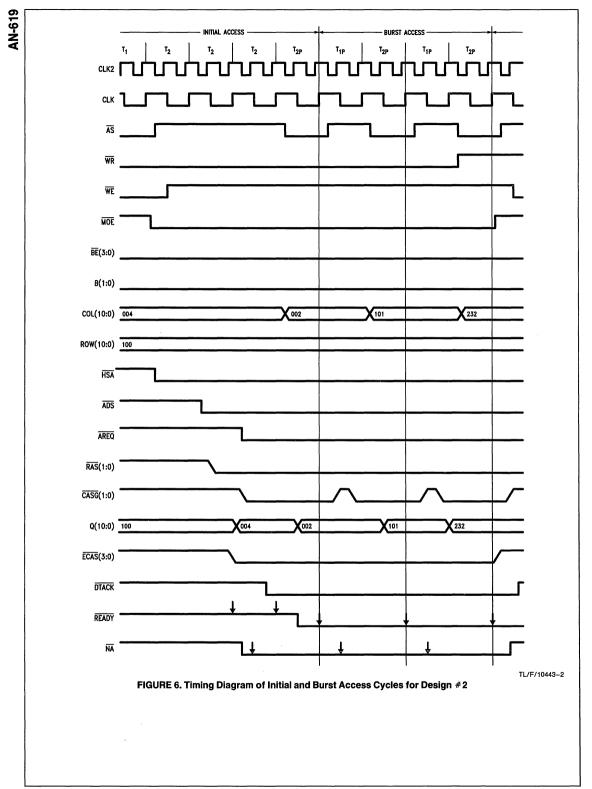
/BED3~ = (READY~ \* /ECAS~3) + (/ASD~ \* /ECAS~3) + (/CKD \* /ECAS~3);

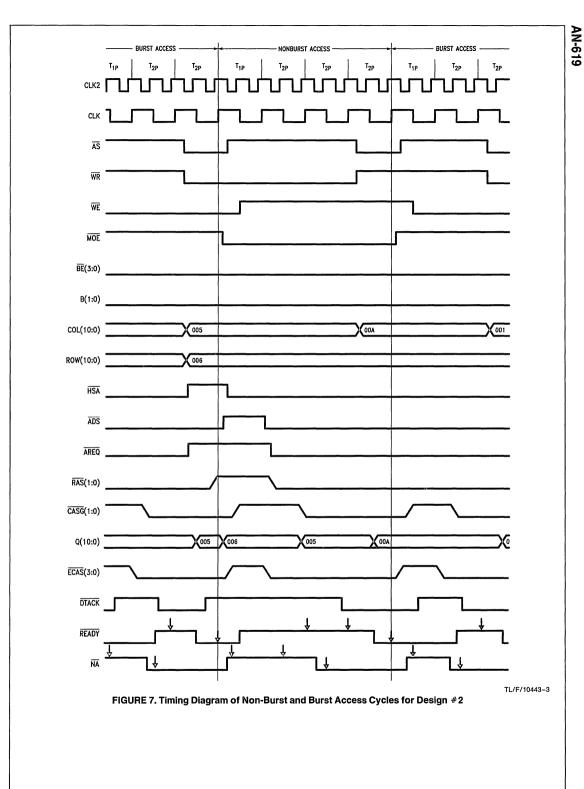
| /BED2~           | = (READY~ * /ECAS~2) + (/ASD~ *<br>/ECAS~2) + (/CKD * /ECAS~2);                                        |
|------------------|--------------------------------------------------------------------------------------------------------|
| /BED1 $\sim$     | = (READY~ * /ECAS~1) + (/ASD~ *<br>/ECAS~1) + (/CKD * /ECAS~1);                                        |
| /BED0~           | = (READY $\sim$ * /ECAS $\sim$ 0) + (/ASD $\sim$ *                                                     |
| /ECAS~3          | <pre>/ECAS~0) + (/CKD * /ECAS~0);<br/>:= (/BE3~ * /CSD~ * READY~)<br/>+ (/BE3~ * /CSD~ * /ADS~);</pre> |
| /ECAS~2          | := (/BE2~ * /CSD~ * READY~)<br>+ (/BE2~ * /CSD~ * /ADS~);                                              |
| /ECAS~1          | := (/BE1~ * /CSD~ * READY~)<br>+ (/BE1~ * /CSD~ * /ADS~);                                              |
| /ECAS~0          | := (/BE0~ * /CSD~ * READY~)<br>+ (/BE0~ * /CSD~ * /ADS~);                                              |
| /ECASHI          | $:= (/ECAS \sim 3 + /ECAS \sim 2 + /ECAS \sim 1 + /ECAS \sim 0;$                                       |
|                  |                                                                                                        |
| IIb. 386PAL1 (F  | AL20R4D) for Design #2 Heavy Load                                                                      |
| Inputs: CLK, B   | E3~, BE2~, BE1~, BE0~, READY~,<br>ASD~, CSD~, WR~, ADS~;                                               |
| Outputs:         |                                                                                                        |
| /BED3~           | = (READY $\sim$ * /ECAS $\sim$ 3) + (ASD $\sim$ *                                                      |
| 10200            | /ECAS~3) + (/CKD * /ECAS~3)<br>+ (MOE~ * ECAS~3);                                                      |
| (0500            |                                                                                                        |
| /BED2~           | = (READY $\sim$ * /ECAS $\sim$ 2) + (ASD $\sim$ *                                                      |
|                  | /ECAS~2) + (/CKD * /ECAS~2)                                                                            |
|                  | + (MOE~ * ECAS~2);                                                                                     |
| /BED1~           | $= (READY \sim * /ECAS \sim 1) + (ASD \sim *)$                                                         |
| /BEDI~           |                                                                                                        |
|                  | /ECAS~1) + (/CKD * /ECAS~1)                                                                            |
|                  | + (MOE $\sim$ * ECAS $\sim$ 1);                                                                        |
| /BED0~           | = (READY~ * /ECAS~0) + (ASD~ *<br>/ECAS~0) + (/CKD * /ECAS~0)                                          |
|                  | + (MOE $\sim$ * ECAS $\sim$ 0);                                                                        |
| 10000            |                                                                                                        |
| 7ECA3~3          | (/BE3~ * /CSD~ * READY~) +                                                                             |
|                  | (/BE3~ * /CSD~ * READY~ * /ASD~)<br>+                                                                  |
|                  | (/BE3~ * /CSD~ * READY~ * /WR~)<br>+                                                                   |
|                  | (/BE3~ * /CSD~ * /ADS~ * READY~)<br>+                                                                  |
|                  | (/BE3~ * /CSD~ * /ADS~) +                                                                              |
|                  | (/BE3~ * /CSD~ * /ADS~ * /WR~);                                                                        |
| $/ECAS \sim 2 =$ | (/BE2~ * /CSD~ * READY~) +                                                                             |
| . 20, 10 2, 1    | (/BE2~ */CSD~ * READY~ * /ASD~)                                                                        |
|                  |                                                                                                        |
|                  | +<br>(/BE2~ * /CSD~ * READY~ * /WR~)<br>+                                                              |
|                  | (/BE2~ * /CSD~ * /ADS~ * READY~)<br>+                                                                  |
|                  | (/BE2~ * /CSD~ * /ADS~) +                                                                              |
|                  |                                                                                                        |
|                  | (/BE2~ * /CSD~ * /ADS~ * /WR~);                                                                        |
| /ECAS~1:=        | (/BE1~ * /CSD~ * READY~) +                                                                             |
|                  | (/BE1~ * /CSD~ * READY~ * /ASD~)<br>+                                                                  |
|                  | (/BE1~ * /CSD~ * READY~ * /WR~)<br>+                                                                   |
|                  | (/BE1~ * /CSD~ * /ADS~ * READY~)<br>+                                                                  |
|                  | (/BE1~ * /CSD~ * /ADS~) +                                                                              |
|                  | (/BE1~ * /CSD~ * /ADS~ * /WR~);                                                                        |
|                  |                                                                                                        |

/ECAS~0:= (/BE0~ \* /CSD~ \* READY~) + (/BE0~ \* /CSD~ \* READY~ \* /ASD~) (/BE0~ \* /CSD~ \* READY~ \* /WR~) (/BE0~ \* /CSD~ \* /ADS~ \* READY~) + (/BE0~ \* /CSD~ \* /ADS~) + (/BE0~ \* /CSD~ \* /ADS~ \* /WR~); /ECASHI:= /ECAS~3 + /ECAS~2 + /ECAS~1 +  $/ECAS \sim 0;$ IIc. 386PAL2 (PAL20R4D) for Design #2 Light and Heavy Load Inputs: CLK, CS~, HSA~, LATCH~, RFSH~, DTACK~, AS~, RFIPD3~, MOE~, ECASHI; Outputs: /ADS~ = (/CS~ \* /AS~) + (/AREQT~ \*  $/LATCH \sim$ ); /AREQ~ = (/HSA~ \* CSD~ \* /AREQT~ \* /CS~ \* AS~) + (/HSA~ \* CSD~ \* /AREQT~ \* /LATCH~) + (/RFSH~ \* /CS~ \* AS~) + (/RFSH~ \* /LATCH~);  $/NASEL \sim = (/CS \sim * /DTACK \sim * /AS \sim) + (/NA-$ SEL~ \* CS~); = (NASEL~ \* /HSA~ \* /CSD~ \* /NA~ /AREQT~) + (/NASEL~ \* /ECASHI \* MOE~) + (/NASEL~ \* /AREQD~ \* /MOE~ \* RFSH~ \* RFIPD3~); := /CS~; /CSD~ /AREQT~:= /HSA~ \* /CSD~;  $/AREQD \sim := /AREQ \sim;$ /ASD~ := /AS~: IId. 386PAL3 (PAL16R4D) for Design #2 Light and Heavy Load Inputs: CLK, CK, RCO~, ML~, RAS~3, RFRQ~, RFIP~, TEN~, WR~; Outputs:  $/LATCH \sim = /RCO + RFSH \sim;$  $/RFSHCK \sim = /CK + (/LATCH \sim * /RFRQ \sim) +$ (/LATCH \* /RAS~3); /RFSH~ = /TEN $\sim$  + LATCH $\sim$ ; /RFIPD1~ := /RFIP~;  $/RFIPD2 \sim := /RFIPD1 \sim :$  $/RFIPD3 \sim := /RFIPD2 \sim :$ /MOE~ := /WR~; IIe. 386PAL4 (PAL16R4D) for Design #2 Light and Heavy Load

Inputs: CLK2, DTACK~, CSD~, HSA~, RFSH~, CK, CNT0, CNT1, CNT2, MOE~; Outputs: /TEN~ = /CNT0 \* CNT1 \* /CNT2;

/CKD = /CK; /READY~ := (/DTACK~ \* CK) + (/READY~ \* /CK); /ADSHI~ := (/CSD~ \* /HSA~ \* RFSH~) + /RFSH~; /WE~ := /MOE~;

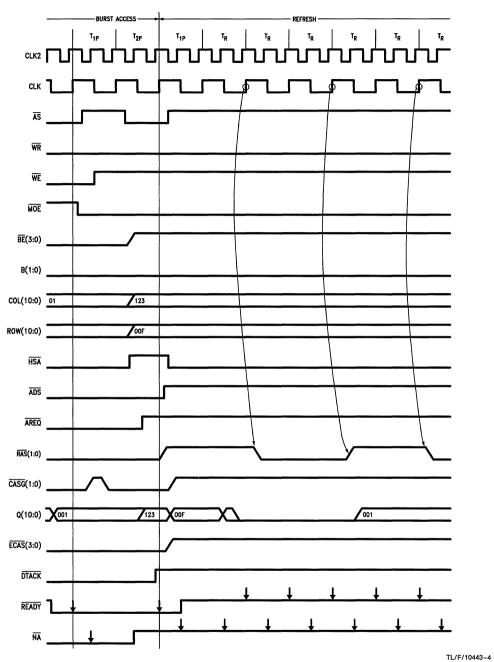


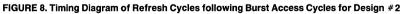


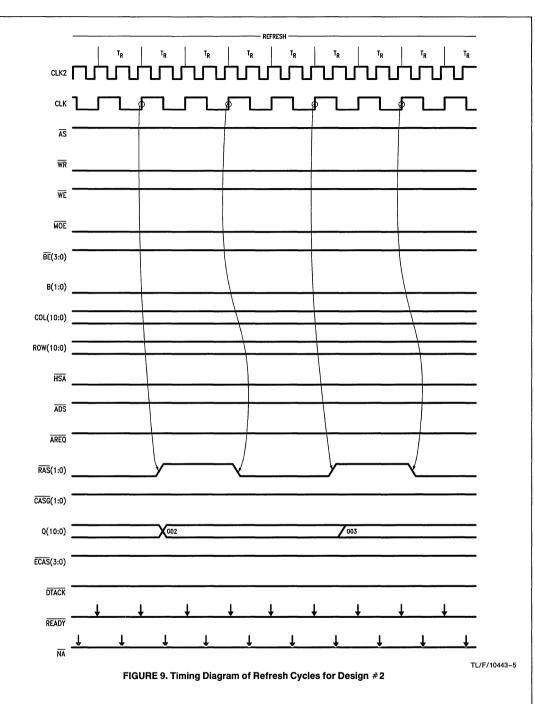
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# Interfacing the DP8420A/21A/22A to the 29000 Utilizing the Burst Access Mode

National Semiconductor Application Note 602 Webster (Rusty) Meier Jr.



### INTRODUCTION

This application note describes how to interface the 29000 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). The DP8422A supports the 29000 in the burst access mode. It is assumed that the reader is already familiar with 29000 access cycles and the DP8422A modes of operation.

IA. Description of Designs #1 and #2, the 29000 in burst access mode on the instruction bus, allowing operation up to 25 MHz with four wait states in normal accesses and one or two wait states in burst accesses

The two designs of this application note consist of the DP8422A DRAM controller, a single PAL® (PAL16L8D), several flip-flops, and several logic gates. These parts interface to the 29000 as shown in the block diagrams. This design accommodates two banks of DRAM, each bank being 32 bits in width, giving a maximum memory capacity of 32 Mbytes (using 4M-bit X 1 DRAMs).

This memory design supports burst accesses by the 29000 to the instruction bus but could also support burst accessing to the data bus given a few minor changes. Design #1 inserts 4 wait states in normal accesses and 2 wait states in burst accesses. Design #2 inserts 4 wait states in normal accesses and 1 wait state in burst accesses. When idle states occur during a burst access the next occurring access will only have one wait state.

This application allows page mode DRAMs to be used by holding RAS low after an access is completed (IRDY low) until either a refresh request or a new access request (IREQ) is generated. If IBREQ (Instruction Burst Request) has transitioned low the next sequential word is accessed from the DRAM via a page mode access. This access involves incrementing the column address (DP8422A COLINC input high) and toggling the CAS outputs via the PAL ECAS output. The instruction burst acknowledge (IBACK) input is driven low except in the case of a refresh request (RFRQ) or a new access (IREQ) being requested.

If the user wants to do dual accessing with the DP8422A DRAM controller, address buffers (74AS244s) must be added to the address,  $\overline{ECAS0-3}$ ,  $\overline{LOCK}$ , and  $\overline{WIN}$  inputs.

Note that the DP8422A DRAM controller could be used to allow instruction memory accessing thru Port A. The instruction memory could be loaded thru a data memory interface to Port B.

The logic shown in these applications form a complete 29000 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A. arbitration between Port A, and refreshing the DRAM:
- B. the insertion of wait states to the processor (Port A) when needed;
- C. remaining in burst access mode unless a refresh request (RFRQ) or new instruction request is generated;
- D. incrementing the column address during burst mode accesses; and

E. guaranteeing the RAS and CAS low and precharge times. The timing calculations for this design are included in this application note.

When using the DP8420A/21A/22A at or above 20 MHz the user should program three clock periods of precharge. This is because two clock periods of precharge at 20 MHz will only guarantee 77 ns of RAS precharge ( $2 \times 50$  ns - tD1, parameter #50 "14 ns" - clock (20 MHz) to AREQ high "9 ns").

### IB. High Performance NO WAIT State 29000 System

A higher performance 29000 system (similar to the ones discussed in this application note) could be designed using the DP8422A by accessing four RAS banks at once, this could allow zero wait state burst accesses. An example of this method using 2 DRAM banks is shown at the end of this application note. If 2 DRAM controllers were used (4 BANKs) burst accesses could execute in zero wait states. The COLINC inputs to the two DRAM controllers would be staggered in time as well as the four ECAS outputs (B0ECAS-B3ECAS) from the 29000 control logic block.

| Programming<br>Bits        | Description                                                                                                                                                                |  |
|----------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| R0 = 1<br>R1 = 1           | $\overline{RAS}$ low four clocks, $\overline{RAS}$ precharge of three clocks                                                                                               |  |
| R2 = 1<br>R3 = 0           | $\overrightarrow{\text{DTACK}}$ will be asserted on the positive edge of CLK following the access $\overrightarrow{\text{RAS}}$                                            |  |
| R4 = 0<br>R5 = 0<br>R6 = X | No WAIT states during burst accesses                                                                                                                                       |  |
| R7 = 1                     | DTACK output                                                                                                                                                               |  |
| R8 = 1<br>R9 = X           | Non-address pipelining to support burst accessing                                                                                                                          |  |
| C0 = X<br>C1 = X<br>C2 = X | Select based upon the input clock frequency. Example: if the DELCLK frequency is 20 MHz then choose $C0,1,2 = 0,0,0$ (divide by ten, this will give a frequency of 2 MHz). |  |
| C3 = X                     |                                                                                                                                                                            |  |
| C4 = 0<br>C5 = 0<br>C6 = 1 | RAS and CAS groups selected by "B1". This mode allows two RAS and four CAS outputs to go low during an access.                                                             |  |
| C7 = 1<br>C8 = 1           | Column address setup time of 0 ns.<br>Row address hold time of 15 ns                                                                                                       |  |
| C9 = 1                     | Delay CAS during write accesses to one clock after RAS transitions low.                                                                                                    |  |
| B0 = 0                     | Latching of the address inputs, needed for the burst accessing<br>capability of the 29000 (COLINC input in particular).                                                    |  |
| B1 = 1                     | Access mode 1                                                                                                                                                              |  |

0 = Program with low voltage level 1 = Program with high voltage level

X = Program with either low voltage level (don't care condition)

# III. 29000 25 MHz timing calculations for Design #1 and Design #2, with four wait states per normal access and one or two wait states per burst access

1. Maximum time to address valid (with respect to 25 MHz clock):

14 ns (29000 data sheet #6)

- Maximim time to ADS low (with respect to 25 MHz clock):
   9 ns (74AS374 clock to Q, tPHL)
- 3. Minimum ADS low setup time to CLK high (DP8422-25 needs 25 ns, #400b):

40 ns (one clock period, 25 MHz) - 9 ns (#2) = 31 ns

4. Minimum address setup time to ADS low (DP8422-25 needs 14 ns, #404):

40 ns (One clock period, 25 MHz) + 2 ns (minimum 74AS374 clock to Q) - 14 ns (#1) = 28 ns

5. Minimum CS setup time to CLKA high (DP8422-25 needs 5 ns, #401):

24 ns (#4) - 9 ns (74AS138 decoder = 15 ns

6. Determining tRAC (RAS access time needed by the DRAM):

200 ns (five clock periods at 25 MHz) - 40 ns (one clock period, T1) - 9 ns (#2) - 6 ns (29000 data setup time, #9a) - 7 ns (74F245) - 29 ns (CLK to  $\overline{\text{RAS}}$  low) = 109 ns

Therefore the tRAC of the DRAM must be 109 ns or less.

7. Determining tCAC (CAS access time needed by the DRAM) and tAA (column address access time):

200 ns - 40 ns - 9 ns - 6 ns - 7 ns - 82 ns (CLK to  $\overrightarrow{\text{CAS}}$  low) = 56 ns

Therefore the tCAC and tAA (access time from the column address) of the DRAM must be 56 ns or less. COM-MON 100 ns DRAMS WILL MEET THIS tRAC, tAA, AND tCAC PARAMETER.

8. Minimum setup of DTACK1 to the 74AS374 ONLY, (need 2 ns):

40 ns (one clock period) - 28 ns (DP8422A-25 DTACK1 delay, #18) = 12 ns

9. Minimum IRDY setup time to IRDY being sampled (12 ns is needed by the 29000, #9):

40 ns (one clock period) - 9 ns (maximum 74AS374 clock to Q output delay) = 31 ns

| 10a. Determining tCAC during a burst access for Design #1:                                                                                                                                                                                                                           | 2<br>b |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 120 ns (3 clock periods) $-$ 20 ns (one half clock period                                                                                                                                                                                                                            | P      |
| during which $\overline{CAS}$ is high) - 10 ns (PAL16L8 maximum                                                                                                                                                                                                                      | Р      |
| propagation delay) - 12 ns (74AS32 propagation de-                                                                                                                                                                                                                                   | c      |
| lay driving $\approx$ 125 pF with damping resistor and other                                                                                                                                                                                                                         | G      |
| associated delays) - 6 ns (data setup time) - 7 ns                                                                                                                                                                                                                                   | Ĩ      |
| (74F245) = 65 ns                                                                                                                                                                                                                                                                     | lf     |
| Therefore the tCAC of the DRAM must be $\leq$ 65 ns                                                                                                                                                                                                                                  |        |
| 10b. Determining tCAC during a burst access for Design                                                                                                                                                                                                                               |        |
| #2:                                                                                                                                                                                                                                                                                  | lf     |
| 80 ns (2 clock periods) $-$ 20 ns (one half clock period during which CAS is high) $-$ 10 ns (PAL16L8 maximum propagation delay) $-$ 12 ns (74AS32 propagation delay driving $\approx$ 125 pF with damping resistor and other associated delays) $-$ 6 ns (data setup time) $-$ 7 ns | lf     |
| (74F245) = 25  ns                                                                                                                                                                                                                                                                    |        |
| Therefore the tCAC of the DRAM must be $\leq$ 25 ns                                                                                                                                                                                                                                  | lf     |
| 11a. Determining tAA during a burst access for Design #1:                                                                                                                                                                                                                            |        |
| 160 ns (4 clock periods, because IRDY inverted is                                                                                                                                                                                                                                    |        |
| COLINC) - 39 ns (DP8422A COLINC to Q's valid,                                                                                                                                                                                                                                        | lf     |
| $#27) = 121 \text{ ns} \ge tAA.$                                                                                                                                                                                                                                                     |        |
| 11b. Determining tAA during a burst access for Design #2:                                                                                                                                                                                                                            |        |
| 120 ns (3 clock periods, because IRDY inverted is                                                                                                                                                                                                                                    |        |
| COLINC) - 39 ns (DP8422A COLINC to Q's valid,                                                                                                                                                                                                                                        |        |
| $#27) = 81 \text{ ns} \ge tAA.$                                                                                                                                                                                                                                                      | lf     |
| IV. 29000 PAL equations, Design #1, 2 wait states dur-                                                                                                                                                                                                                               |        |
| ing burst accesses. Written in National Semiconductor                                                                                                                                                                                                                                | lf     |
| PLAN™ format                                                                                                                                                                                                                                                                         |        |
| PAL16L8D                                                                                                                                                                                                                                                                             |        |
| CLK CS IREQ IBREQ DTACK2 AREQ IRDY IRDY3 RFRQD                                                                                                                                                                                                                                       | lf     |
| GND RESET IBACK ECAS ECAS1 DOACC ENDACC IREQH                                                                                                                                                                                                                                        |        |
|                                                                                                                                                                                                                                                                                      |        |
| If (VCC) IBACK = AREQ*RFRQD*IREQH*DTACK2                                                                                                                                                                                                                                             | K      |
| + AREQ*RFRQD*IREQH*IREQ                                                                                                                                                                                                                                                              | E      |
|                                                                                                                                                                                                                                                                                      |        |
| If (VCC) $\overline{\text{ECAS}} = \overline{\text{AREQ}} * \text{ECAS1} * \overline{\text{DOACC}} * \text{RESET}$                                                                                                                                                                   |        |
| + AREQ*DOACC*IRDY3*CLK*RESET                                                                                                                                                                                                                                                         | Т      |
|                                                                                                                                                                                                                                                                                      | 0      |
|                                                                                                                                                                                                                                                                                      | fo     |
| + ECAS*CLK*RESET                                                                                                                                                                                                                                                                     | tr     |
| If (VCC) $\overline{\text{ECAS1}} = \overline{\text{IRDY}} * \overline{\text{CLK}}$                                                                                                                                                                                                  | 1      |
| + ECAS1*CLK                                                                                                                                                                                                                                                                          |        |
| If (VCC) DOACC = AREQ*RFRQD*IBREQ*RESET                                                                                                                                                                                                                                              | 2      |
|                                                                                                                                                                                                                                                                                      |        |
|                                                                                                                                                                                                                                                                                      | 3      |
| If (VCC) ENDACC = IREQ*IREQH                                                                                                                                                                                                                                                         |        |
|                                                                                                                                                                                                                                                                                      |        |
| + RFRQD*AREQ*IREQH<br>+ ENDACC*AREQ                                                                                                                                                                                                                                                  |        |
| + ENDACC*AREQ<br>+ RESET                                                                                                                                                                                                                                                             |        |
|                                                                                                                                                                                                                                                                                      |        |
| If (VCC) IREQH = AREQ*IREQ<br>+ IREQH*AREQ*RESET                                                                                                                                                                                                                                     |        |
|                                                                                                                                                                                                                                                                                      |        |
| If (VCC) IRDY1 = DTACK2*AREQ*IRDY*IRDY3*IREQH                                                                                                                                                                                                                                        |        |
|                                                                                                                                                                                                                                                                                      |        |
|                                                                                                                                                                                                                                                                                      |        |
| If (VCC) $\overline{\text{AREQ1}} = \overline{\text{CS}} * \overline{\text{IREQ}} * \overline{\text{IRDY}} * \overline{\text{ENDACC}} * \overline{\text{RESET}}$                                                                                                                     |        |
|                                                                                                                                                                                                                                                                                      |        |
| + AREQ1*DOACC*RESET                                                                                                                                                                                                                                                                  |        |
|                                                                                                                                                                                                                                                                                      |        |
|                                                                                                                                                                                                                                                                                      |        |
|                                                                                                                                                                                                                                                                                      |        |

### 29000 PAL equations, Design #2, 1 wait state during burst accesses. Written in National Semiconductor PLAN format

### PAL16L8D

CLK CS IREQ IBREQ DTACK2 AREQ IRDY IRDY3 RFRQD GND RESET IBACK ECAS ECAS1 DOACC ENDACC IREQH IRDY1 AREQ1 VCC

- If (VCC) IBACK = AREQ\*RFRQD\*IREQH\*DTACK2 + AREQ\*RFRQD\*IREQH\*IREQ + IBACK\*IREQH\*RFRQD
- If (VCC)  $\overline{\text{ECAS}} = \overline{\text{AREQ}}^{\text{*}} \text{ECAS1}^{\text{*}} \overline{\text{DOACC}}^{\text{*}} \text{RESET} + \overline{\text{AREQ}}^{\text{*}} \overline{\text{DOACC}}^{\text{*}} \overline{\text{IRDY}}^{\text{*}} \overline{\text{CLK}}^{\text{*}} \text{RESET}$ 
  - + AREQ\*DOACC\*CLK\*RESET
  - + ECAS\*ECAS1\*CLK\*RESET
  - + ECAS\*CLK\*RESET
- If (VCC)  $\overline{\text{ECAS}}1 = \overline{\text{IRDY}}*\overline{\text{CLK}}$ +  $\overline{\text{ECAS}}1*CLK$
- If (VCC)  $\overline{DOACC} = \overline{AREQ}^{*}RFRQD^{*}\overline{IBREQ}^{*}RESET + \overline{CS}^{*}\overline{IREQ}^{*}RESET + \overline{DOACC}^{*}REDV^{*}RESET$
- If (VCC) ENDACC = IREQ\*IREQH
  - + RFRQD\*IRDY
    - + RFRQD\*AREQ\*IREQH + ENDACC\*AREQ
    - + ENDACC\* + RESET
- + HESEIIf (VCC)  $\overline{\text{IREQH}} = \overline{\text{AREQ}} + \text{IREQ}$ 
  - + IREQH\*AREQ\*RESET
- If (VCC) IRDY1 = DTACK2\*AREQ\*IREQH + AREQ\*IRDY\*IREQH\*CLK\*DOACC + IRDY1\*IRDY\*AREQ
- If (VCC)  $\overline{AREQ1} = \overline{CS}^*\overline{IREQ}^*IRDY^*ENDACC^*RESET + \overline{AREQ1}^*ENDACC^*RESET$ 
  - + AREQ1\*DOACC\*RESET

### Key: Reading PAL equations written in PLAN

 $\begin{array}{l} \mbox{EXAMPLE EQUATIONS: } \overline{\mbox{READ}}: = \mbox{CS\_RD*ADS1D*} \\ + \mbox{READ}* \mbox{ADS1D} \\ \end{array}$ 

+ READ\*CLKA

This example reads: the output " $\overline{\mathsf{READ}}$ " will transition low on the next rising "CLK" clock edge (given that one of the following conditions are valid a setup time before "CLK" transitions high);

- 1. the input "CS\_RD" is high AND the input "ADS1D" is high AND the input "CLKA" is low, OR
- 2. the output "READ" is low AND the input "ADS1D" is low, OR
- 3. the output " $\overline{\text{READ}}$  " is low AND the input "CLKA" is high

### V. 29000 application note PAL and 74AS374 outputs

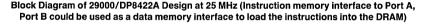
What follows is a brief explanation of the PAL and 74AS374 outputs:

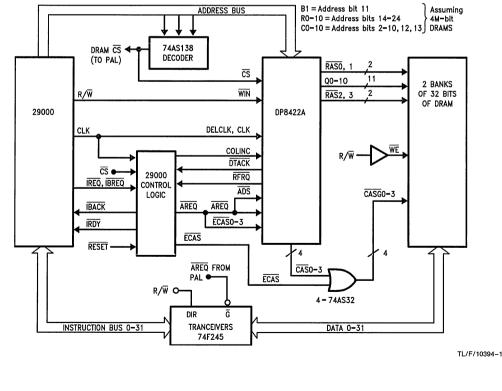
- AREQ1This combinational output of the PAL is sampled at the next rising clock edge (74AS374) to<br/>provide the ADS and AREQ outputs that drive<br/>the DP8422A DRAM accesses. This output is<br/>held low to allow burst accessing until either a<br/>new access is requested by the 29000 (IREQ)<br/>or a refresh is requested (RFRQ).
- IRDY1 This combinational output of the PAL is sampled at the next rising clock edge (74AS374) to provide the IRDY output that terminates each 29000 access.
- ENDACC This combinational output of the PAL is used internal to the PAL as an indication of when to terminate a burst, or single, access. It indicates a new page access (IREQ), a refresh request (RFRQ), or a hardware reset (RESET) operation. Accesses are only terminated after IRDY is issued or during idle states when no accesses are pending.

- DOACC This combinational output of the PAL is used internal to the PAL to keep track of requested accesses, single (IREQ) or burst (IBREQ and IBACK).
- ECAS1 This combinational output of the PAL is used internal to the PAL to allow the ECAS output to have minimum delay following the CLK high and low.
- ECAS This combinational output of the PAL is used to toggle the CAS outputs of the DP8422A during burst accessing.
- IBACK This combinational output of the PAL is used as an input to the 29000 to indicate when the DP8422A is available to support burst accessing. This output is pulled high during refresh requests (RFRQ) and out of page accesses (IREQH = IREQ = low).
- AREQ See AREQ1 explanation.

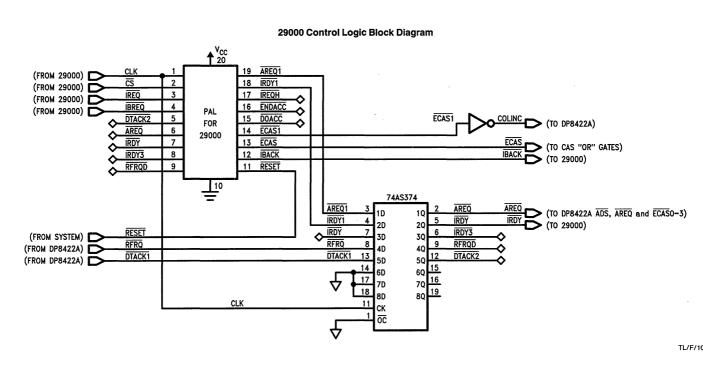
IRDY See IRDY1 explanation.

- IRDY3 This output (74AS374) is used as a state input to the PAL. This term is IRDY delayed by one clock period.
- RFRQD This clocked output is used to synchronize the DP8422A RFRQ output.
- DTACK2 This clocked output is generated from the DP8422A DTACK1 output and is synchronized to the next rising clock edge.

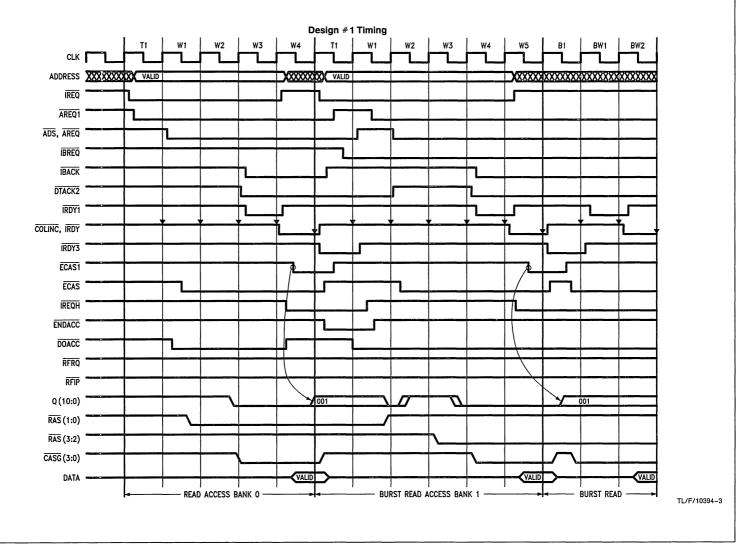




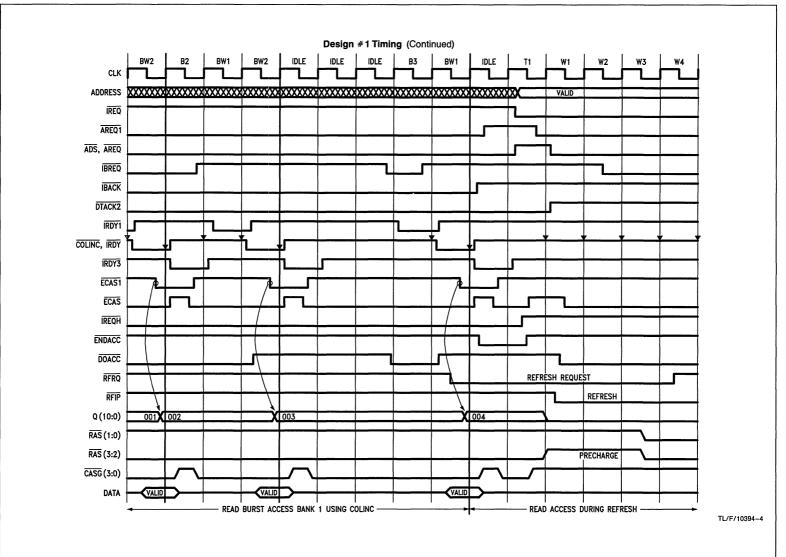




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Design #1 Timing (Continued) W11 W13 W4 W5 W6 W7 W9 W10 W12 BW1 BW2 IDLE IDLE W8 B1 CLK ADDRESS VALID IREQ AREQ1 ADS, AREQ IBREQ IBACK DTACK2 IRDY1 COLINC, IRDY IRDY3 ECAS1 ECAS IREQH 17 ENDACC DOACC RFRQ RF1P REFRESH Q (10:0) X 001 002 RAS (1:0) RAS (3:2) PRECHARGE CASG (3:0) DATA VALID VALID - READ BURST ACCESS DURING REFRESH TL/F/10394-5

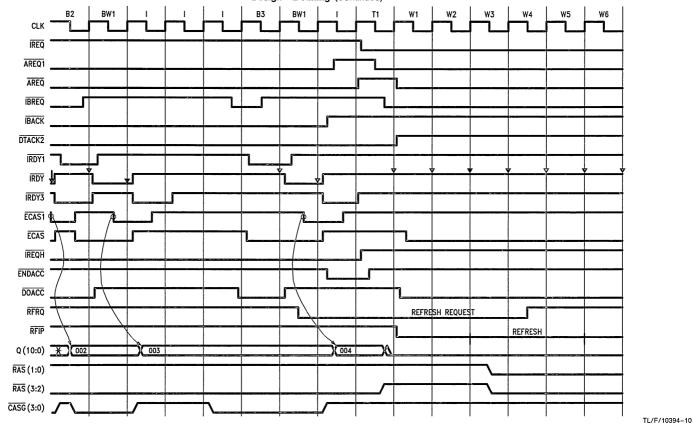
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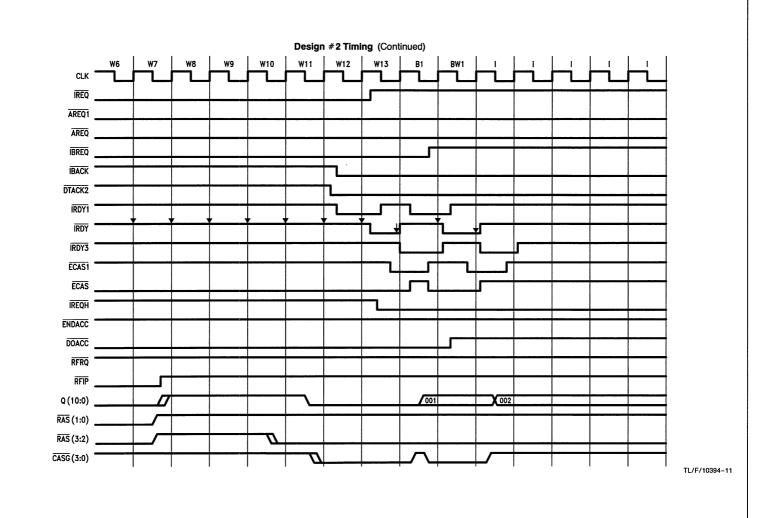
Design #2 Timing (Continued)

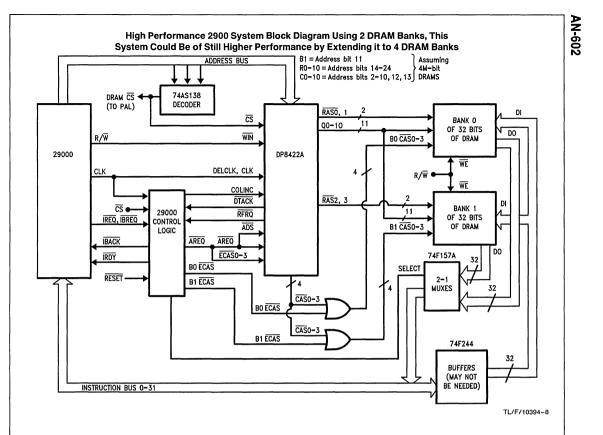


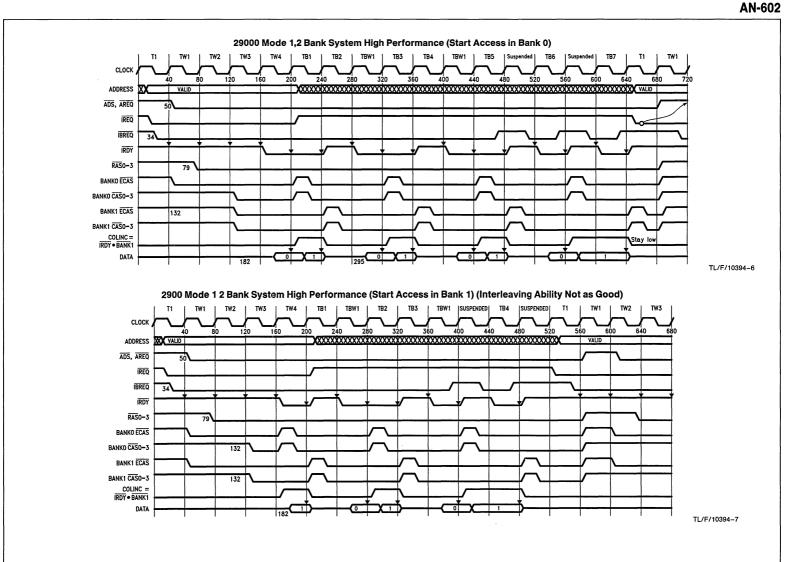
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### Interfacing the DP8420A/21A/22A to the Z280/Z80000/Z8000 Microprocessor

National Semiconductor Application Note 546 Webster (Rusty) Meier, Jr. and Joe Tate



### **I INTRODUCTION**

This application note describes how to interface the Z280 microprocessor to the DP8422A DRAM controller (also applicable to DP8420A/21A). It is assumed that the reader is already familiar with Z280 and the DP8422A modes of operation. The interface to the Z80000 and Z8000 is similar to the interface described in this application note.

### II DESCRIPTION OF DESIGN, ALLOWING OPERATION AT 10 MHz (AND ABOVE) WITH 1 WAIT STATE IN NOR-MAL ACCESSES AND 1 WAIT STATE DURING BURST ACCESSES

The block diagram of this design is shown driving two banks of DRAM, each bank being 16 bits in width, giving a maximum memory capacity of up to 16 Mbytes (using 4 M-bit  $\times$  1 DRAMs). By choosing a different RAS and CAS configuration mode (see programming mode bits section of DP8422A data sheet) this application can support 4 banks of DRAM, giving a memory capacity of up to 32 Mbytes (using 4 M-bit  $\times$  1 DRAMs).

The memory banks are interleaved on every four word (16bit word) boundry. This means that the address bit (A3) is tied to the bank select input of the DP8422A (B1).

Address bits A2,1 are tied to the most significant row and column address inputs (R9,C9 for 1 Mbit DRAMs) to support burst accesses using static column mode DRAMs. Since this application assumes the use of static column DRAMs the column address strobe (CAS) is left low throughout the entire burst access. If the user desires to use nibble mode or page mode DRAMs the CAS outputs must be toggled, the ECAS inputs the DP8422A can be used for this purpose (DS of the Z280 could be "OR"ed with the current ECAS inputs). If nibble mode DRAMs are used the COLINC input of the DP8422A need not be driven.

Address bit A0 is used to produce the two byte select data strobes along with the byte/word signal (B/W). These byte selects (Byte 0  $\overline{\text{ECAS}}$  and Byte 1  $\overline{\text{ECAS}}$ ) are used in byte reads and writes as well as selects for the transceivers.

If the majority of accesses made by the Z280 are sequential, the Z280 can be doing burst accesses most of the time. Each burst of four words can alternate memory banks, allowing one memory bank to be precharging (RAS precharge) while the other bank is being accessed (Bank select, B1, tied to address A3). This is a higher performance memory system then a non-interleaved memory system (bank select on the higher address bits). Each separate memory access to the same memory bank may require extra wait states to be inserted into the CPU access cycles to allow for the RAS precharge time, if two periods or more of RAS precharge were programmed. This application allows 1 or more wait states to be inserted in normal accesses and 1 or more wait states to be inserted during burst accesses of the Z280. The number of wait states can be adjusted through the WAITIN input of the DP8422A.

The logic shown in this application note forms a complete Z280 memory sub-system, no other logic is needed. This sub-system automatically takes care of:

- A. arbitration between Port A, Port B, and refreshing the DRAM;
- B. the insertion of wait states to the processor (Port A and Port B) when needed (i.e., if RAS precharge is needed, refresh is happening during a memory access, the other Port is currently doing an access . . .etc);
- C. performing byte writes and reads to the 16-bit words in memory;
- D. normal and burst access operations.

The external wait logic (U1, U2, U3, U4; see *Figure 1*) is needed to support burst accesses of the Z280. During burst accesses the Z280 WAIT input is sampled every falling clock edge. What is worse is that the WAIT input needs one half clock period setup time and the DS signal (used to toggle ECAS0-3 and thereby toggle the DP8422A WAIT output) takes close to one half of a clock period to transition high. This leaves no time for the DP8422A WAIT output to transition between states. The external flip-flop is used to provide extra fast response time for normal access wait states and to toggle when doing a burst mode access. If the user is not going to do burst accesses the WAIT output can be tied directly to the WAIT input of the Z280 (U1, U2, U3, U4 would not be needed). Also all this logic could easily be put into a PAL® if desired.

By using the "output control" pins of some external latches (74ALS373's), this application can easily be used in a dual access application. The addresses could be TRI-STATE® through these latches, the write input (WIN), lock input (LOCK), and ECAS0-3 inputs must also be able to be TRI-STATE (a 74AS244 could be used for this purpose). By multiplexing the above inputs (through the use of the above parts and similar parts for Port B) the DP8422A can be used in a dual access application. If this design is used in a dual access application. If this design is used in a dual access time required by the DRAM) will have to be recalculated since the time to  $\overline{RAS}$  and  $\overline{CAS}$  is longer for the dual access application (see TIMING section of this application note).

### III Z280 DESIGN, 10 MHz WITH 1 WAIT STATE DURING NORMAL ACCESSES AND 1 WAIT STATE DURING BURST ACCESSES, PROGRAMMING MODE BITS

| Programming<br>Bits                               | Description                                          |  |
|---------------------------------------------------|------------------------------------------------------|--|
| R0 = 0                                            | RAS low two clocks, RAS precharge                    |  |
| R1 = 1                                            | of two clocks, this setup                            |  |
|                                                   | will only guarantee 93.5 ns RAS                      |  |
|                                                   | precharge (at 10 MHz) from refresh                   |  |
|                                                   | RAS high to access RAS low. If more                  |  |
|                                                   | RAS precharge is desired the user                    |  |
|                                                   | should program three periods of RAS                  |  |
| <b>D0</b> - 0                                     | precharge.<br>DTACK one half is chosen. DTACK        |  |
| R2 = 0<br>R3 = 1                                  | low first rising CLK edge                            |  |
| H3 - 1                                            | after access RAS is low.                             |  |
| R4 = 0                                            | No WAIT states during burst accesses                 |  |
| R5 = 0                                            |                                                      |  |
| R6 = 0                                            | If $\overline{\text{WAITIN}} = 0$ , add one clock to |  |
|                                                   | DTACK. WAITIN may be tied high or                    |  |
|                                                   | low in this application depending upon               |  |
|                                                   | the number of wait states the user                   |  |
|                                                   | desires to insert into the access.                   |  |
| R7 = 1                                            | Select DTACK                                         |  |
| R8 = 1                                            | Non-interleaved Mode                                 |  |
| R9 = X                                            |                                                      |  |
| C0 = X                                            | Select based upon the input                          |  |
| C1 = X                                            | "DELCLK" frequency. Example: if the                  |  |
| C2 = X                                            | input clock frequency is 10 MHz then                 |  |
|                                                   | choose C0,1,2 = 1,0,1 (divide by five,               |  |
| C3 = X                                            | this will give a frequency of 2 MHz).                |  |
| C3 = x<br>C4 = 0                                  | RAS groups selected by "B1". This                    |  |
| C5 = 0                                            | mode allows two RAS outputs to go                    |  |
| C6 = 1                                            | low during an access, and allows byte                |  |
|                                                   | writing in 16- or 32-bit words.                      |  |
| C7 = 1                                            | Column address setup time of 0 ns                    |  |
| C8 = 1                                            | Row address hold time of 15 ns                       |  |
| C9 = 1                                            | Delay CAS during write accesses to                   |  |
|                                                   | one clock after RAS transitions low                  |  |
| B0 = 0                                            | Latches latch on ALE input low                       |  |
| B1 = 0                                            | Access mode 0                                        |  |
| $\overline{\text{ECAS}}0 = 0$                     | CASn not extended beyond RASn                        |  |
| 0 = Program with low voltage level                |                                                      |  |
| 1 = Program with high voltage level               |                                                      |  |
| X = Program with either high or low voltage level |                                                      |  |
| (don't care condition)                            |                                                      |  |

### IV Z280 TIMING CALCULATIONS FOR DESIGN AT 10 MHz WITH 1 WAIT STATE DURING NORMAL ACCESSES AND 1 WAIT STATE DURING BURST ACCESSES

1. Minimum ALE high setup time to CLOCK high if using the on-chip latches and more then one RAS bank (DP8422A-20 needs 29 ns, #301b):

100 ns (one clock period) - 20 ns ( $\overline{\text{AS}}$  valid maximum delay, #3 of Z280 data sheet) - 11 ns (74ALS04B max delay) = 69 ns

2A. Minimum address setup time to ALE low (DP8422A-20 needs 3 ns, #306):

25 ns (address setup to  $\overline{AS}$  high, #20 Z280 data sheet) + 1 ns (74ALS04B min delay) = 26 ns

- 2B. Minimum address hold time to ALE low (DP8422A-20 needs 10 ns, #305):
  20 ns (address hold from AS high, #22 of Z280 data sheet) + 1 ns (74ALS04B min delay) = 21 ns
- 2C. Minimum address setup to CLOCK high (DP8422A-20 needs bank address setup to CLOCK of 20 ns, #303): 100 ns (one clock period) 20 ns (max clock to address valid, Z280 data sheet #2) = 80 ns
- Minimum CS setup time to clock high (DP8422A-20 needs 14 ns, #300): 80 ns (#2C above) - 22 ns (max 74ALS138 decoder) = 58 ns
- Determining t<sub>RAC</sub> during a normal access (RAS access time needed by the DRAM):

250 ns (two and one half clock periods to do the access) -32 ns (CLK to RAS low max, DP8422A-20 #307) -30 ns (Z280 data setup time, #9) -10 ns (74ALS245A max delay) = 178 ns

Therefore the  $t_{RAC}$  of the DRAM must be 178 ns or less. (One can see that if zero wait states would have been programmed the  $t_{RAC}$  would have been 84 ns (using DP8422A-25, has faster CLK to RAS low of 26 ns) 184–100 (one clock)).

Determining t<sub>CAC</sub> during a normal access (CAS access time) and column address access time needed by the DRAM:
 250 ns - 89 ns (CLK to CAS low on DP8422A-20,

#308a) - 30 ns - 10 ns = 121 nsTherefore the t<sub>CAC</sub> of the DRAM must be 121 ns or less.

6. Determining the column address access time needed during a static column mode burst access:

20 ns (two clocks to do the access, Ex. mid T3 to mid TBW to mid T4) - 35 ns ( $\overline{\text{DS}}$  high, Z280 parameter #8) - 43 ns (COLINC asserted to address outputs of DP8420A-20 incremented, #27) - 30 ns (Z280 data setup time, #9) - 10 ns (74ALS245A max delay) = 82 ns

Therefore the column address access time of the DRAM must be 82 ns or less. (One can see that if zero wait states would have been programmed the column address access time would have been less then 0 ns (82 - 100 (one clock))).

 Maximum time to DTACK one half low (74ALS374 D type flip-flop needs 10 ns setup to CLK):

100 ns (One clock, mid T2 in mid TW) - 33 ns (DTACK one half low from CLK high on DP8422A-20, #18) - 12 ns (max delay on 74ALS02 = 55 ns

 Minimum WAIT setup time to CLK low (Z280 WAIT input needs 50 ns, #14):

100 ns (one clock period) - 16 ns (74ALS374 max delay) - 14 ns (74ALS08 max delay) = 70 ns

9. Minimum RAS precharge (DP8422A programmed with 2 clock periods of RAS precharge):

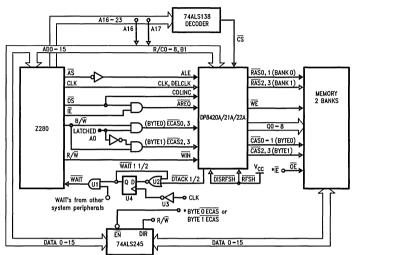
Since the  $\overline{AREQ}$  input of the DP8422A will go high from DS and  $\overline{IE}$  both being high the  $\overline{AREQ}$  high setup to clock rising edge (DP8422A parameter #29b, 19 ns) parameter is violated. This means that the rising clock edge following  $\overline{AREQ}$  high may or may not be counted.

Since that first rising clock edge could be counted, and would give less  $\overline{RAS}$  precharge time, we must assume this condition in the calculation of the minimum  $\overline{RAS}$  precharge. Therefore:

200 ns (2 clock periods) -50 ns (half clock period before both  $\overline{E}$  and  $\overline{DS}$  transition high) -35 ns ( $\overline{E}$  and  $\overline{DS}$  high, Z280 parameters #8 and #19) -5.5 ns (74AS08 max delay) -16 ns (DP8422A RAS high to RAS low difference parameter #50) = 93.5 ns

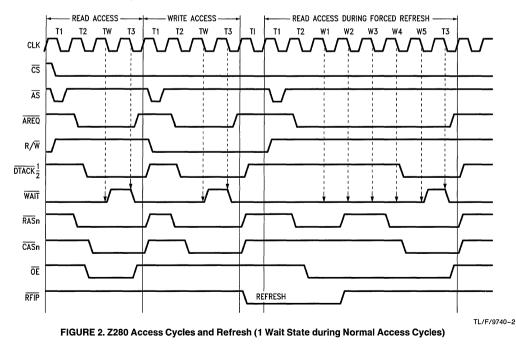
Therefore, the user should guarantee that the DRAM he is using needs a RAS precharge time of 93.5 ns or less. If more RAS precharge time is needed the user should program the DP8422A with 3 periods of RAS precharge (R0, R1) during programming.

Note: Calculations can be performed for different frequencies and/or different combinations of wait states by substatuting the appropriate values into the above equations.

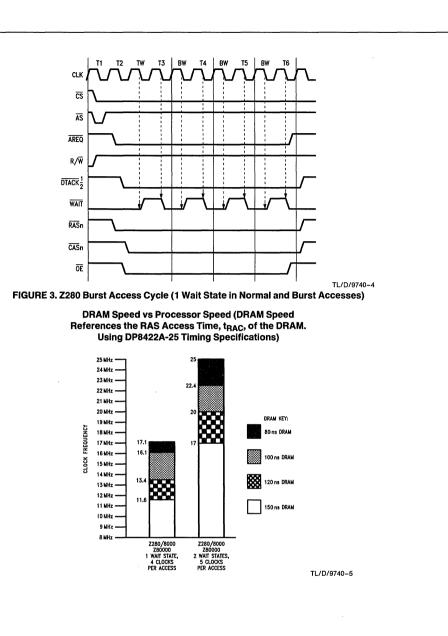


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\*The user may want to gate OS ("OR" Gate) with the signals that produce OE to the DRAMs and EN to the transceivers FIGURE 1. 10 MHz Z280 Design (Z-bus Interface), 1 Wait State in Normal Accesses, 1 Wait State in Burst Accesses







### Interfacing the Dual Port DP8422A to the TMS320C30 and the VME Bus

### INTRODUCTION

This application note describes how to interface the TMS320C30 Digital Signal Processor (DSP) and the VME bus to the DP8422A DRAM Controller. This system is running at 16 MHz. It is assumed that the reader is familiar with the DP8422A, TMS320C30, and VME bus operations.

### DESCRIPTION

This design consists of Port A of the DP8422A interfaced to the primary bus of TMS320C30 DSP and Port B interfaced to the VME bus. The DP8422A is operated in access Mode 1 and uses the interleaving capability on chip. A Port A access cycle begins when the TMS320C30 places a valid address on the address bus and asserts the strobe (/STRB) signal, only if a refresh or Port B (VME bus) access is not in progress. GRANTB of the DP8422A indicates which port is currently granted to do an access. Port A is the default port upon power up. This design accommodates 4 banks of DRAM (256K x 4), 32 bits in each bank, giving maximum memory capacity of 4M bytes. The schematic diagram is shown in *Figure 1* and simple timing diagrams are shown in *Figures 2* and 3. National Semiconductor Application Note 642 Lawson Chang



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### PROGRAMMING MODE AND BITS

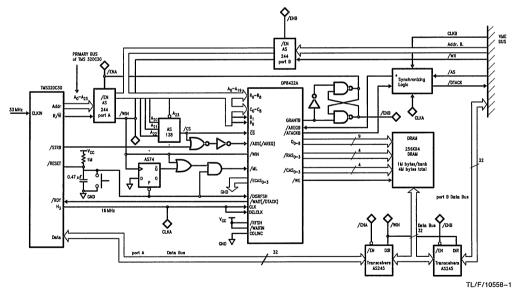
Programming the DP8422A is on the first TMS320C30 DSP write after power up. 60 ms initialization period is needed right after this chip access write access programming.

### Programming Bits

- u = user defined, x = don't care.R0, R1 = u, u R2, R3 = u, u R4, R5, R6 = x, x, x R7 = 1 R8 = 0 R9 = u C0, C1, C2 = 0 1 0 (16 MHz) C3 = 0 C4, C5, C6 = u, u, u (or 0, 1, 1)
- C7, C8 = u, u

$$C9 = 1$$
  
 $B0 = 0$ 

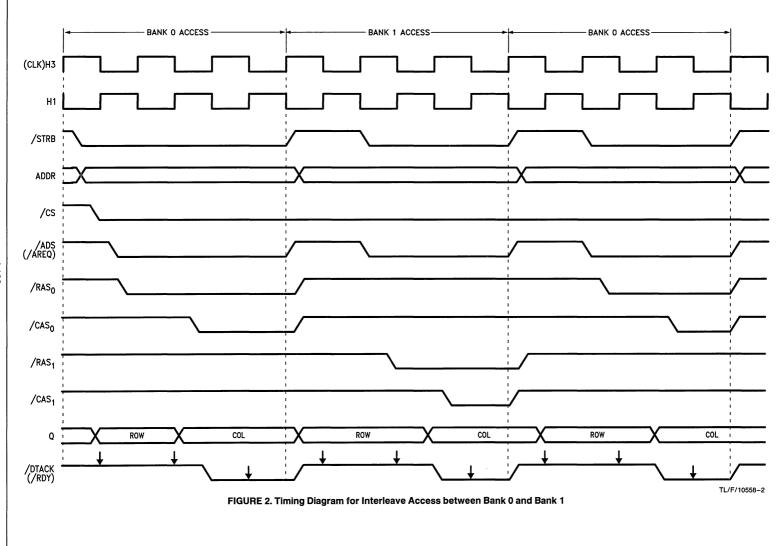
$$B1 = 1$$



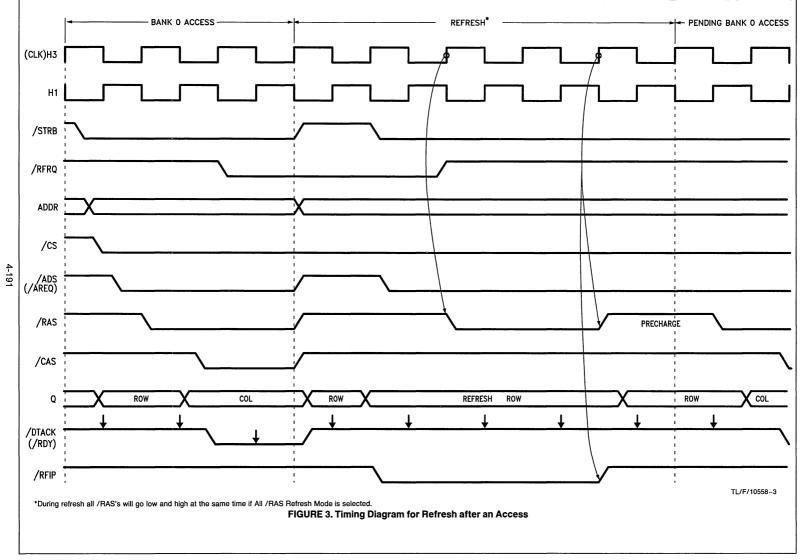
### FIGURE 1. Interfacing DP8422A/TMS320C30 Schematic Diagram (Interleave Mode)

\*Please refer to Interfacing the DP8422A to an Asychronous Port B in a Dual 68020 System application note.





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## Port A Wait Support for the DP8420A/21A/22A, DP8420V/21V/22V, DP84T22V, DP8430V/ 31V/32V, DP8520A/21A/ 22A and NS32CG821A DRAM Controllers

National Semiconductor Application Note 773



#### INTRODUCTION

This application brief looks into the wait support offered by the above DRAM controllers. All of these controllers behave in the same way with respect to the insertion of wait states; therefore, this application brief is valid to any and all of them.

Wait states are necessary for interfacing fast microprocessors with slower memory or I/O devices. CPU manufacturers name differently their Wait or Ready input line, however, any CPU's Wait or Ready input is compatible to either the WAIT or DTACK output from these DRAM controllers. These outputs basically extend the normal CPU cycle to ensure: 1) that valid data is on the data bus before the CPU latches this information into its registers, (in the read cycle) and 2) that data is long enough on the data bus for the data of the bus, (in the write cycle).

Both WAIT and DTACK signals are active low but with different meaning. WAIT asserted means that while this output is low wait states will be inserted in the memory cycle. DTACK asserted means that when this output is low the transfer has taken place and the memory cycle may be finished by the CPU.

The user must first decide which kind of output is required by the CPU in his or her application, and program the DRAM controller accordingly (programming bit R7).

For example, the <u>68000/08/10/20/30/40</u> and i286/i386/i486 uses a <u>READY</u> input active low, (named differently by each CPU). This input asserted indicates to the microprocessor that data has been written into memory or that valid data is on the bus for the CPU to latch into its registers. In the case of a memory cycle, the DRAM controller must keep this signal high and assert it low when it is ready to indicate that the access may finish. As long as the CPU samples this signal high, wait states will be inserted into the access cycle. These microprocessors can use the DTACK type output from the DRC.

On the other hand, Intel's 8086/8088/186 and NSC's NS32008/016/132, to name a few, use the READY input active high. When this signal is sampled high by the micro-processor, it indicates that the transfer can be finished. In the case of a memory cycle, the DRAM controller must keep

the signal low and assert it high when it is ready to indicate that the access may finish. While this signal is sampled low by the CPU, wait states will be inserted in the access cycle. These microprocessors can use the WAIT type output from these DRAM controllers.

A microprocessor may request a memory access while the DRAM controller is in the middle of a refresh cycle, in the middle of precharge for the previous access, while a Port B access is in progress, or when the DRAM controller is idle or free. In any case, the DRAM controller arbitrates between accesses, refreshes and precharge, and two situations may arise: 1) A Delayed Access meaning that a refresh cycle, precharge time or other access was in progress when the access was requested. And 2) A Non-Delayed Access which means that no refresh cycle, precharge time or other access was requested.

### NON-DELAYED ACCESS

If WAIT is selected, the DRAM controller will assert this output, normally high, if and only if wait states are programmed. The CPU will prolong the access cycle for as long as WAIT is asserted low. The DRAM controller will bring WAIT high after the programmed wait states allowing the CPU to finish the memory access. If no wait states were programmed, the DRAM controller will keep WAIT high and the CPU will read or write data at the usual CPU cycle.

If  $\overline{\text{DTACK}}$  is selected and because this output is normally high, the DRAM controller will always assert this output to indicate the end of the access. If wait states are programmed, the DRAM controller will assert  $\overline{\text{DTACK}}$  after the programmed wait states. If no wait states are programmed the DRAM controller will assert  $\overline{\text{DTACK}}$  at the beginning of the access from  $\overline{\text{CS}}$  and  $\overline{\text{ADS}}$  (ALE) asserted.

#### DELAYED ACCESS

If **WAIT** is selected, the DRAM controller will assert this output immediately from the access request by  $\overline{CS}$  and  $\overline{ADS}$  (ALE). This will insert wait states allowing precharge or the refresh cycle to finish. After precharge or the refresh cycle is over, the previously requested access will start by asserting RAS, at that time the WAIT output will follow the programming selection on bits R2, R3.

If  $\overline{\text{DTACK}}$  is selected, the DRAM controller will keep this output negated high allowing precharge or the refresh cycle to finish. After precharge or the refresh cycle is over, the previously requested access will start by asserting  $\overline{\text{RAS}}$ , at that time the  $\overline{\text{DTACK}}$  output will follow the programming selection on bits R2, R3.

The user may choose to read only the section regarding his particular design,  $\overline{WAIT}$  Type Output or  $\overline{DTACK}$  Type Output. In each section 4 possible programming selections are shown. Every programming selection explains the behavior of Mode 0 and Mode 1. In each mode the access can be Non Delayed or Delayed. See table below.

|    |    | WAIT Output Selected |         |                 | DTACK Output Selected |                 |         |                 |         |
|----|----|----------------------|---------|-----------------|-----------------------|-----------------|---------|-----------------|---------|
| R3 | R2 | Mode 0               |         | Mode1           |                       | Mode 0          |         | Mode 1          |         |
|    |    | Non-<br>Delayed      | Delayed | Non-<br>Delayed | Delayed               | Non-<br>Delayed | Delayed | Non-<br>Delayed | Delayed |
| 0  | 0  | ОТ                   | ОТ      | ОТ              | OT                    | ОT              | ОТ      | 0Т              | ОТ      |
| 0  | 1  | ОТ                   | 1⁄₂T    | ОТ              | 1∕₂T                  | 1⁄₂T            | 1∕₂T    | 1⁄₂T            | 1⁄₂T    |
| 1  | 0  | 1⁄₂T                 | 1⁄₂T    | 1∕₂T            | 1∕2T                  | 1T              | 1T      | 1T              | 1T      |
| 1  | 1  | 1T                   | 1T      | 1T              | 1T                    | 11/2T           | 11/2T   | 11/2T           | 11∕₂T   |

#### WAIT AND DTACK SUPPORT

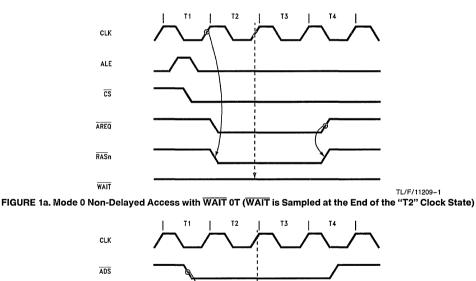
#### Wait During Single Accesses

WAIT can be programmed to delay a number of positive edges and/or negative levels of CLK. These options are

| R3 | R2 | Mode        | 0       | Mode        | 1       |
|----|----|-------------|---------|-------------|---------|
|    |    | Non-Delayed | Delayed | Non-Delayed | Delayed |
| 0  | 0  | ОТ          | ОТ      | ОT          | ОТ      |

cs

programmed through address bits R2 and R3 at programming time. The user is given four options described below: OT during non-delayed and delayed acceses. During a nondelayed access, WAIT will stay negated as shown in *Figures 1a* and *1b*.

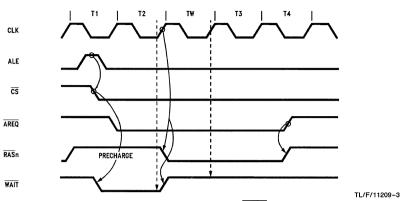


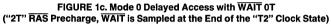
# RAS TL/F/11209-2

FIGURE 1b. Mode 1 Non-Delayed Access with WAIT 0T (WAIT is Sampled at the End of the "T2" Clock State)

During an access that is delayed, WAIT will assert at the start of the access (CS and ALE or ADS) and it will negate

from the positive edge of  $\overline{\text{CLK}}$  that starts  $\overline{\text{RAS}}$  for that access as shown in *Figures 1c* and *1d*.





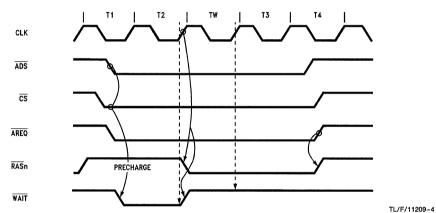
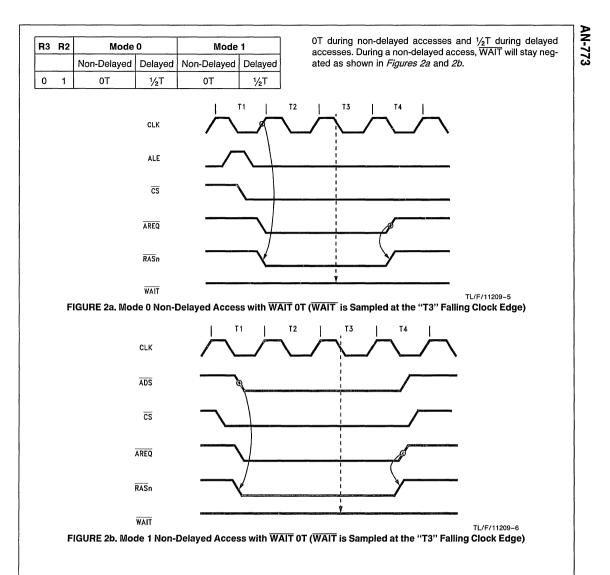


FIGURE 1d. Mode 1 Delayed Access with WAIT 0T (WAIT is Sampled at the End of the "T2" Clock State)

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During an access that is delayed, WAIT will assert at the start of the access (CS and ALE or ADS) and WAIT will negate on the negative level of CLK after the positive edge of CLK that asserted RAS for that access, as shown in Figures 2c and 2d.

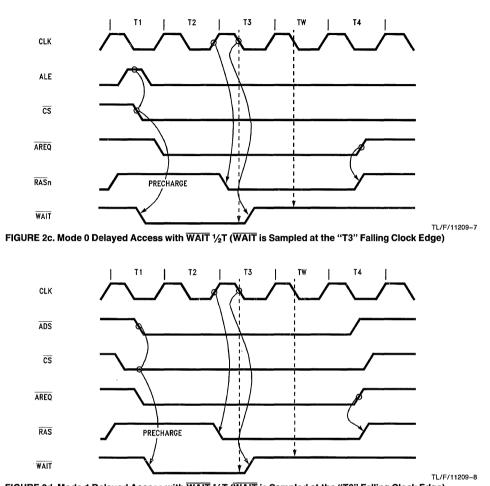
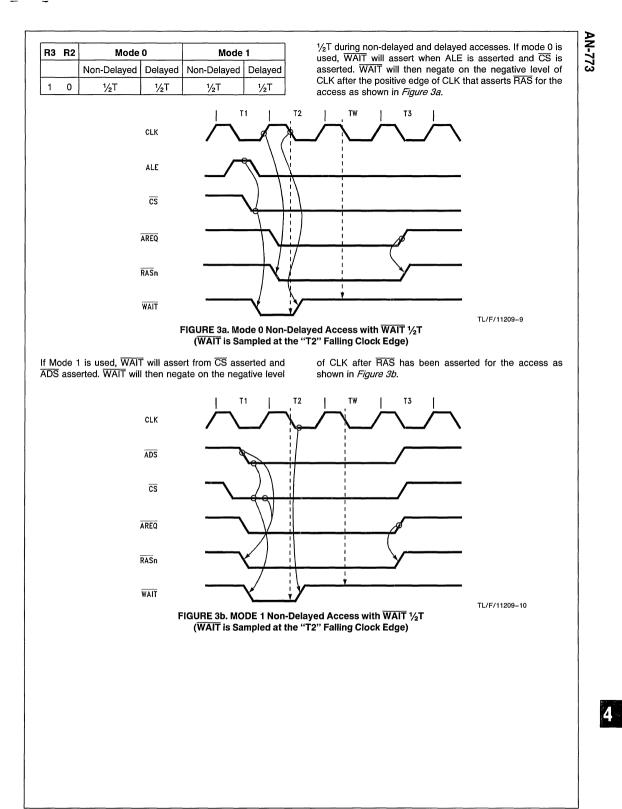
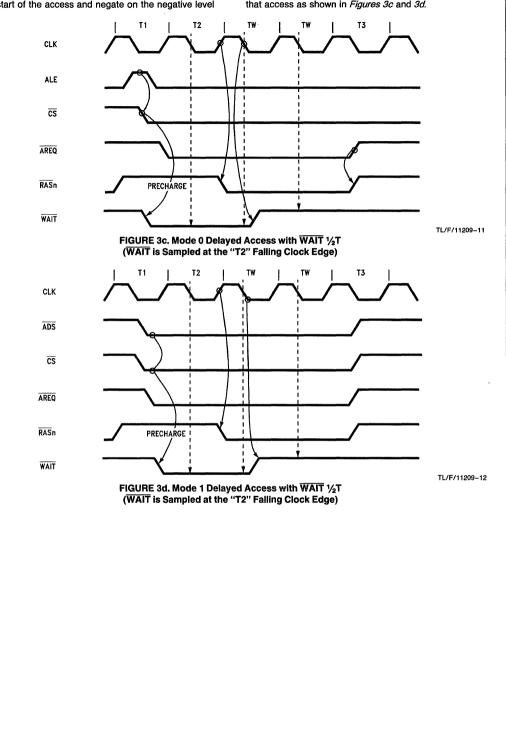


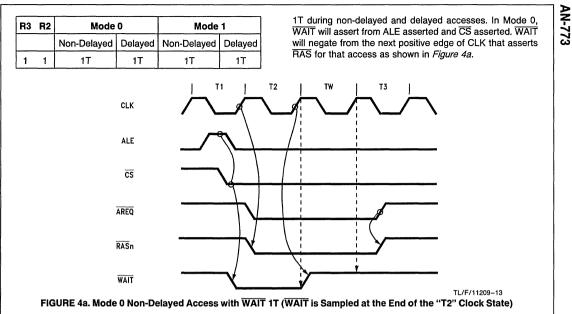
FIGURE 2d. Mode 1 Delayed Access with WAIT 1/2T (WAIT is Sampled at the "T3" Falling Clock Edge)

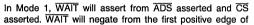


During delayed accesses, in both modes,  $\overline{\text{WAIT}}$  will assert at the start of the access and negate on the negative level

of CLK after the positive edge of CLK that started  $\overrightarrow{\text{RAS}}$  for that access as shown in *Figures 3c* and *3d*.







CLK after ADS and CS have been asserted as shown in Figure 4b.

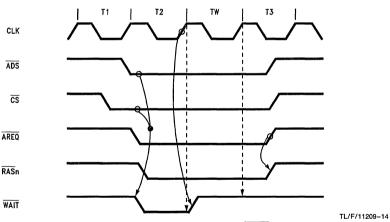


FIGURE 4b. Mode 1 Non-Delayed Access with WAIT 1T (WAIT is Sampled at the End of the "T2" Clock State)

During delayed accesses in both modes, WAIT will assert at the beginning of the access and will negate on the next

positive edge of CLK after the positive edge of CLK that starts RAS for that access as shown in Figures 4c and 4d.

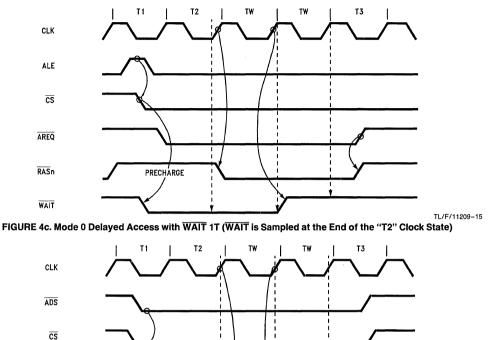


FIGURE 4d. Mode 1 Delayed Access with WAIT 1T (WAIT is Sampled at the End of the "T2" Clock State)

When ending WAIT from a negative level of CLK, if RAS is asserted while CLK is high then WAIT will negate from the negative edge of CLK. If RAS is asserted while CLK is low then WAIT will negate from RAS asserting.

PRECHARGE

AREQ

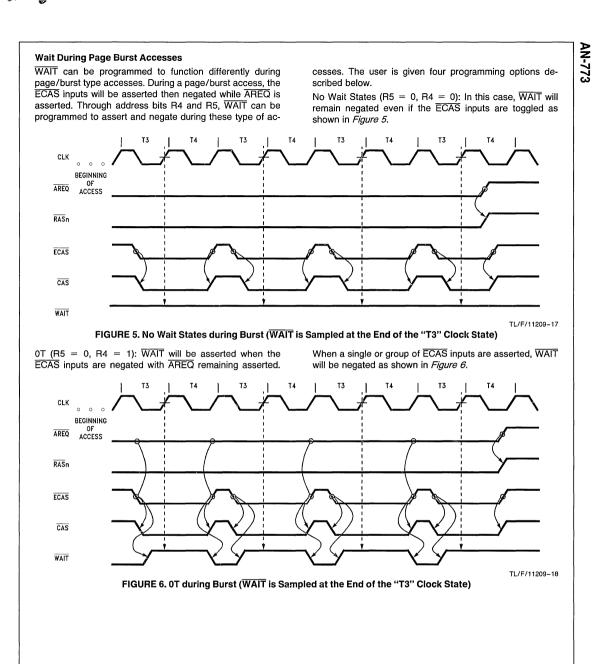
RASn

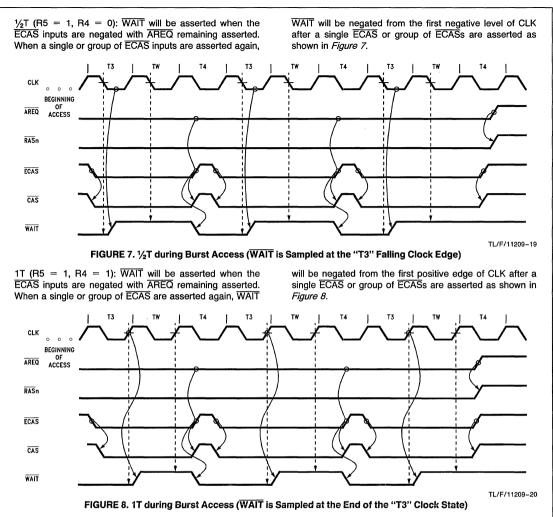
WAIT

When ending WAIT from a positive edge of clock in Mode 0, the user can think of the positive edge of CLK that starts RAS as 0T and the next positive edge of CLK as 1T.

When ending WAIT from a positive edge of clock in Mode 1, the positive edge of CLK that ADS is setup to, can be thought of as 1T in a non-delayed access. In a delayed access, the positive edge of CLK that starts RAS can be thought of as 0T and the next positive edge as 1T.

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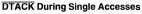




When ending  $\overline{WAIT}$  from a negative level of CLK: If the ECAS are asserted while CLK is high, then  $\overline{WAIT}$  will negate from the negative edge of CLK. If the ECAS are asserted while CLK is low, then  $\overline{WAIT}$  will negate from the ECASs asserting.

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When ending  $\overline{\text{WAIT}}$  from a positive edge of CLK, the positive edge of CLK that  $\overline{\text{ECAS}}$  is set up to, can be thought of as 1T.



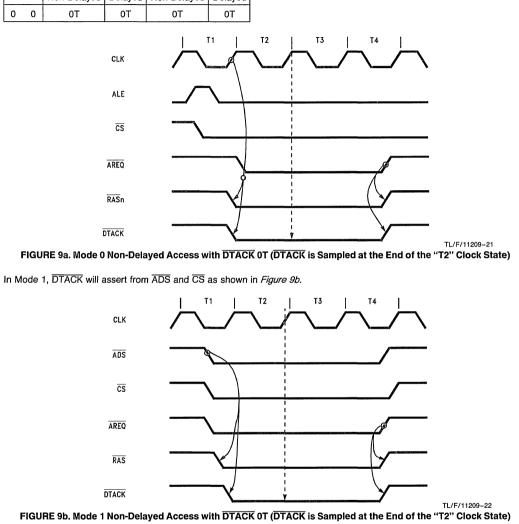
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 $\overline{\text{DTACK}}$  can be programmed to delay a number of positive edges and/or negative levels of CLK. These options are

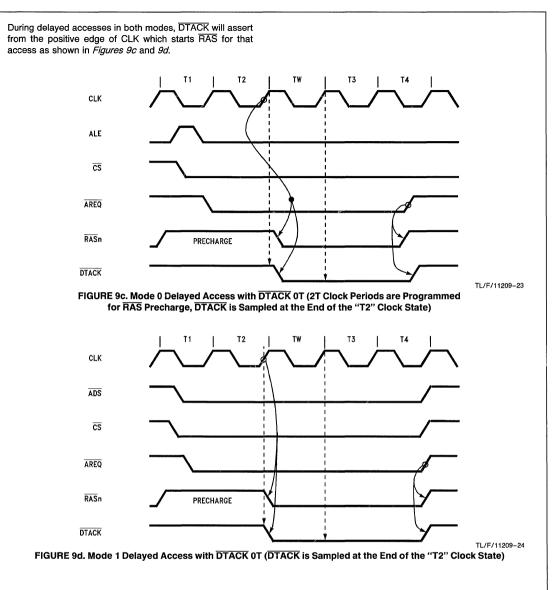
| R3 | R2 | Mode        | 0       | Mode        | 1       |
|----|----|-------------|---------|-------------|---------|
|    |    | Non-Delayed | Delayed | Non-Delayed | Delayed |
| 0  | 0  | ОT          | OT      | ОТ          | 0Т      |

programmed through address bits R2 and R3 at programming time. The user is given four options described by the following.

0T During Non-Delayed and Delayed Accesses. In Mode 0, DTACK will assert from the positive edge of CLK that starts RAS as shown in *Figure 9a*.



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| R3 | R2 | Mode        | 0       | Mode        | 1       |
|----|----|-------------|---------|-------------|---------|
|    |    | Non-Delayed | Delayed | Non-Delayed | Delayed |
| 0  | 1  | ¹⁄₂T        | ¹⁄₂T    | 1⁄₂T        | ¹⁄₂T    |

 $\frac{1}{2}$ T During Non-Delayed and Delayed Accesses. In Mode 0, DTACK will asert on the negative level of CLK after the positive edge of CLK that starts RAS as shown in *Figure 10a*.

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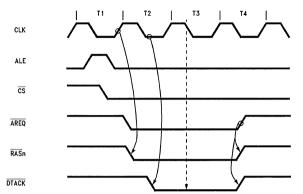


FIGURE 10a. Mode 0 Non-Delayed Access with DTACK of 1/2T (DTACK is Sampled at the "T3" Falling Clock Edge)

In Mode 1,  $\overline{\text{DTACK}}$  will assert from the negative level of clock after  $\overline{\text{ADS}}$  has been asserted, given that  $\overline{\text{RAS}}$  is asserted as shown in *Figures 10b* and *10c*.

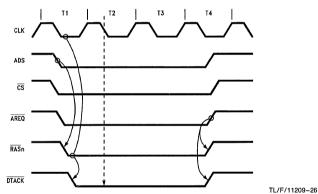
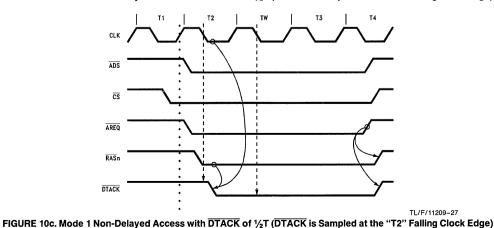
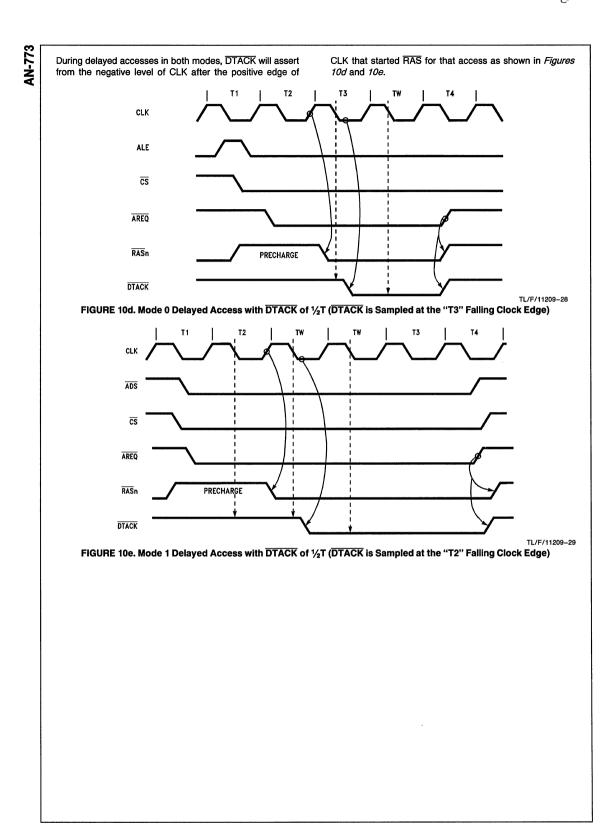
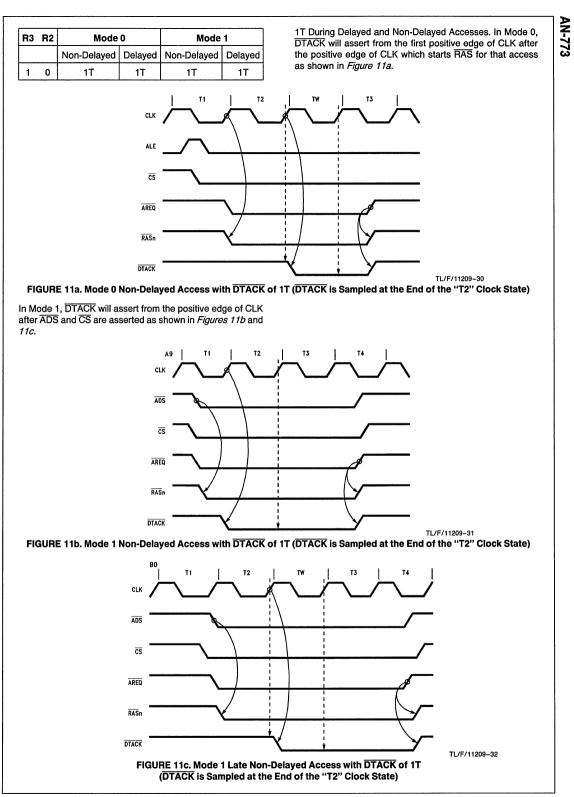


FIGURE 10b. Mode 1 Non-Delayed Access with DTACK of 1/2T (DTACK is Sampled at the "T2" Falling Clock Edge)

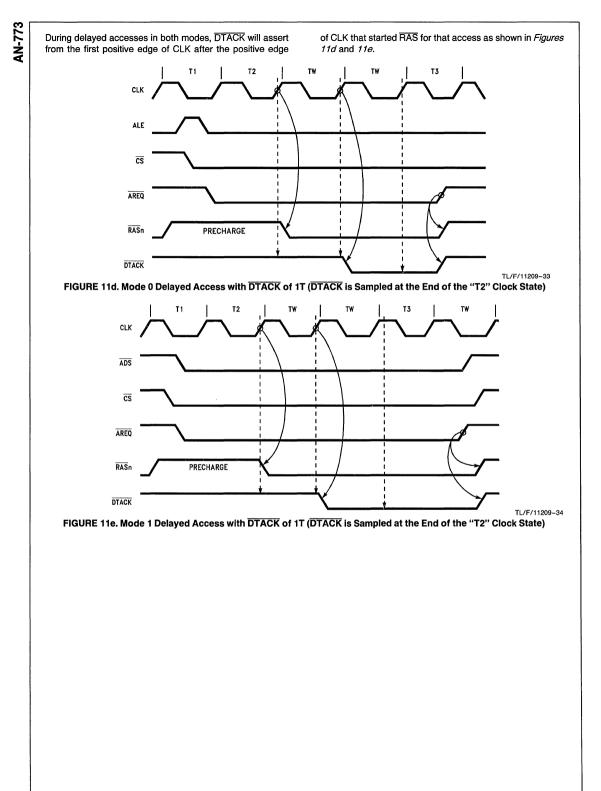


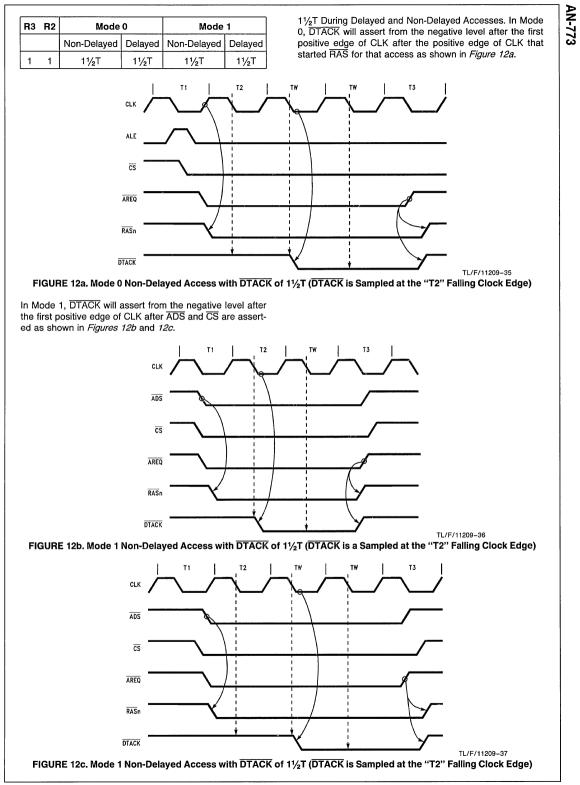
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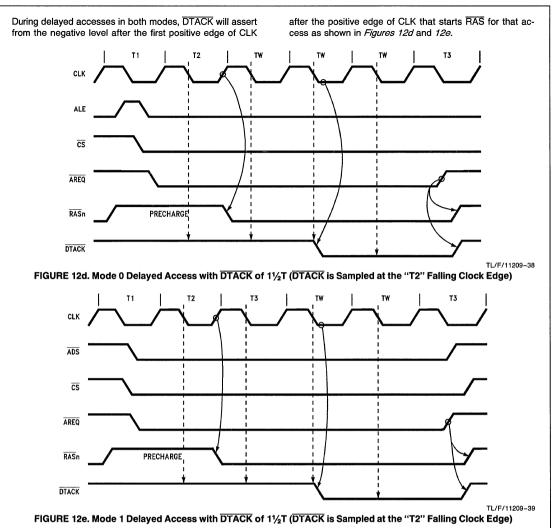




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When starting  $\overline{\text{DTACK}}$  from a negative level of CLK: If  $\overline{\text{RAS}}$  is asserted while CLK is high, then  $\overline{\text{DTACK}}$  will assert from the negative edge of CLK. If  $\overline{\text{RAS}}$  is asserted while CLK is low, then  $\overline{\text{DTACK}}$  will assert from  $\overline{\text{RAS}}$  asserting. When starting  $\overline{\text{DTACK}}$  from a positive edge of CLK: In Mode 0, the positive edge of CLK that starts  $\overline{\text{RAS}}$  can be thought of as OT.

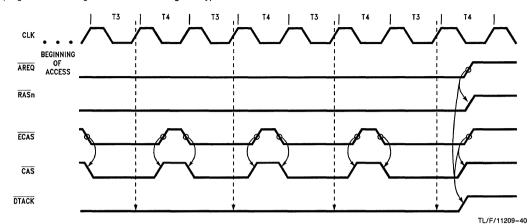
In Mode 1, during non-delayed accesses, the positive edge of CLK that  $\overline{ADS}$  is set up to, can be thought of as 1T. During delayed accesses, the positive edge of CLK that starts  $\overline{RAS}$  can be thought of as 0T and the next positive edge of CLK as 1T.

#### DTACK During Page/Burst Accesses

DTACK can be programmed to function directly page/burst types of accesses. During a page/burst access, the ECAS inputs will be asserted then negated while AREQ remains asserted. Through address bits R4 and R5, DTACK can be programmed to negate and assert during this type of ac-

cess. The user is given four programming options described below.

No Wait States (R5=0, R4=0): In this case,  $\overrightarrow{\text{DTACK}}$  will remain asserted even if the  $\overrightarrow{\text{ECAS}}$  inputs are negated with  $\overrightarrow{\text{AREQ}}$  asserted as shown in *Figure 13*.







gle or group of ECAS inputs are asserted again, DTACK will be asserted as shown in *Figure 14*.

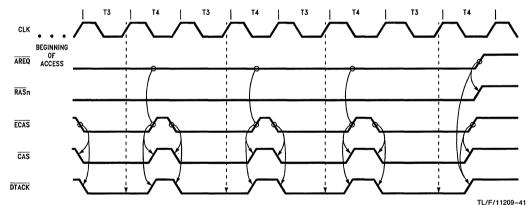


FIGURE 14. 0T During Burst Access (DTACK is Sampled at the End of the "T3" Clock State)

 $\frac{1}{2T}$  (R5=1, R4=0): DTACK will be negated when the ECAS inputs are negated with AREQ asserted. When a single or group of ECAS inputs are asserted again, DTACK will

be asserted from the first negative level of CLK after the single or group of  $\overline{\text{ECAS}}$  are asserted as shown in Figure 15.

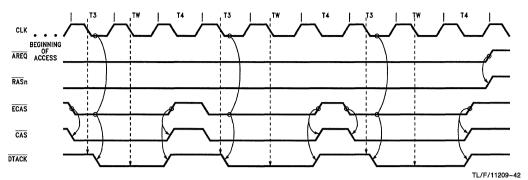


FIGURE 15. 1/2T during Burst Access (DTACK is Sampled at the "T3" Falling Clock Edge)

1T (R5 = 1, R4 = 1):  $\overline{\text{DTACK}}$  will be negated when the ECAS inputs are negated with  $\overline{\text{AREQ}}$  asserted. When a single or group of ECAS are asserted again,  $\overline{\text{DTACK}}$  will be

asserted from the first positive edge of CLK after the single or group of  $\overline{\text{ECAS}}$  are asserted as shown in *Figure 16.* 

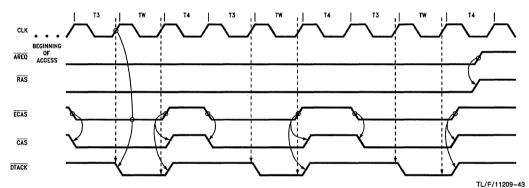


FIGURE 16. 1T During Burst Access (DTACK is Sampled at the "T3" Falling Clock Edge)

When starting  $\overline{\text{DTACK}}$  from a negative level of CLK: If the  $\overline{\text{ECAS}}$  are asserted while CLK is high, then  $\overline{\text{DTACK}}$  will assert from the negative edge of CLK. If the  $\overline{\text{ECAS}}$  are asserted while CLK is low, then  $\overline{\text{DTACK}}$  will assert from the  $\overline{\text{ECAS}}$  asserting.

When starting DTACK from a positive edge of CLK, the positive edge of CLK that ECAS is set up to, can be thought of as 1T.

#### CONCLUSION

By inserting wait states the normal CPU access cycle is increased and all signals associated with the access are extended. A CPU access cycle can be increased by one or by multiple CPU clock periods so that the memory cycle can be successfully terminated. Extending the access cycle allows slower memories to have the necessary extra time to respond in a reliable way to the CPU. The insertion of wait states will ensure that data from the DRAM will be present when the CPU reads or that data has been written into the DRAM before the CPU terminates cycle.





Section 5 Microprocessor Application for the NS32CG821

## Section 5 Contents AN-576 Interfacing the NS32CG821 to the NS32CG16 .....

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# Interfacing the NS32CG821 to the NS32CG16

#### INTRODUCTION

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This application note explains how to interface the NS32CG821 to the NS32CG16 microprocessor. It is assumed that the reader is familiar with the NS32CG16 access cycles and operation of the NS32CG821.

#### DESIGN DESCRIPTION

This design is a simple circuit to interface the NS32CG821 to the NS32CG16 and up to 8 Mbytes of DRAM. An access cycle begins when the NS32CG16 asserts the ADS signal and places a valid address on the bus. The ADS places a pair of 74F373 fall-through latches in fall-through mode and on the negating edge of ADS latches the address to guarantee that the address is valid throughout the entire access. The ADS signal is inverted to produce the signal ALE to the NS32CG821. On the next rising clock edge, after the ALE signal is asserted, the NS32CG821 will assert RAS. After guaranteeing the row address hold time, t<sub>BAH</sub>, the NS32CG821 will place the column address on the DRAM address bus, guarantee the column address setup time and assert CAS. During read cycles, the DRAM will place valid data on the bus after the DRAM, t<sub>CAC</sub>, timing has been met. During write cycles, CAS will be delayed until after T3re, to ensure that the CPU's write data is valid before CAS is asserted.

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The N32CG821 will also take complete care of the DRAM's refresh needs. There is an internal 15 microsecond timer, and a refresh address counter. Refresh access arbitration will be controlled by an internal state machine. It will allow current cycles to complete before starting the refresh cycle. If a refresh cycle is in progress the NS32CG16 will be held off completing the access by asserting the CWAIT signal to the NS32CG16.

During programming of the chip, it is recommended that the user gate  $\overline{ML}$  (Mode Load) and ( $\overline{TSO}$ ) (Timing State Output) for the connection onto the  $\overline{ML}$  pin of the NS32CG821. This is to ensure that the chip will be programmed while a valid access address is present.

Timing parameters are referenced to the numbers shown in the NS32CG821 data sheet, and are included in each equation in *italics* to indicate the target specifications that need to be satisfied. Times that begin with a "\$" refer to the NS32CG821 data sheet unless otherwise stated times use "NS32CG821-20" part's parameters with heavy loading; these times are generally worse than the "NS32CG821-25" part. Times that begin with a "#" refer to the NS32CG16 data sheet. Equations are provided so that the user can calculate timing based on their frequency and application.

#### CLK спі DELCLK CWAIT WAIT TSO TSO WR WIN address Q0-9 CS, ML decode RASO-3 CASO-3 NS32CG16 R0-9 latched address bus WF A16-23 CO-9 BO, B1 DRAM HBE ECAS1, 3 ARRAY A0 ECASO, 2 (up to 8 MB) AD0-15 NS32CG821 ADS ALE 04 data bus 245 TL/F/10130-1 \*Standard components in any NS32CG16 design.

## NS32CG16-NS32CG821 Connection Diagram

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#### **DESIGN TIMING PARAMETERS**

Timing diagrams are supplied further on in this document. Clock Period =  $T_{cp}10 = 100$  ns @ 10 MHz  $= T_{cn}15 = 66 \text{ ns} @ 15 \text{ MHz}$ \$300: CS Asserted to CLK High (only A20-A23 are used for decode) 14 ns Min @ NS32CG821-20. 13 ns Min @ NS32CG821-25 = T1 - (CTTL to address valid + B-PAL delav)  $= T_{CD} - #t_{AHv} - t_{Bpal}$ = 100 ns - 40 ns - 15 ns = 45 ns @ 10 MHz = 66 ns - 30 ns - 15 ns = 21 ns @ 15 MHz \$301a: ALE Setup to CLK High 16 ns Min @ NS32CG821-20, 15 ns Min @ NS32CG821-25 = T1 - Inverter Max - CTTL to ADS = T<sub>cp</sub> - t<sub>plh</sub> - #t<sub>ADSa</sub> = 100 ns - 5 ns - 35 ns = 60 ns @ 10 MHz = 66 ns - 5 ns - 26 ns = 35 ns @ 15 MHz \$302: ALE Pulse Width 18 ns Min @ NS32CG821-20. 13 ns Min @ NS32CG821-25 = #t<sub>ADSw</sub> 30 ns @ 10 MHz = 25 ns @ 15 MHz \$303 & \$304: Address Setup to CLK 20 ns Min @ NS32CG821-20, 18 ns Min @ NS32CG821-25 = T1 - CTTL to Address - F373 In to Out  $= T_{cp} - t_{AHv} - t_{phl}$ = 100 ns - 40 ns - 6 ns = 54 ns @ 10 MHz = 66 ns - 30 ns - 6 ns = 30 ns @ 15 MHz \$310: WIN Setup to CLK High that starts the access RAS (to guarantee CAS is delayed) -21 ns Min @ NS32CG821-20 & - 16 ns Min @ NS32CG821-25 = T1 - (time until WR active)  $= T_{cp} - (T_{cp} + t_{WRa})$ = 100 ns - (100 ns + 20 ns) = -20 ns @ 10 MHz = 66 ns - (66 ns + 15 ns) - 15 ns @ 15 MHz

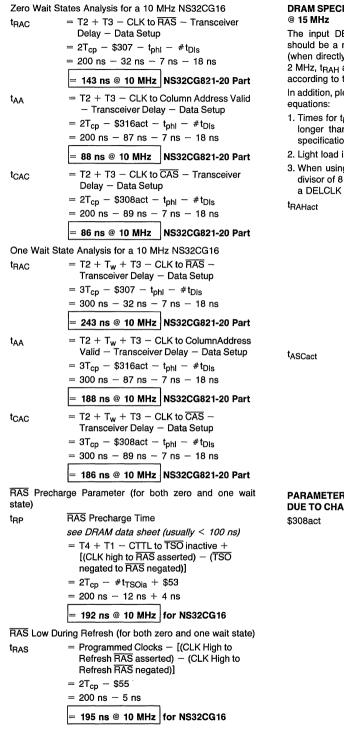
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Timing parameter to guarantee RAS Precharge with 2 Clock Precharge \$29b: TSO negated Setup to CLK High

with > 1 Period of Precharge 19 ns Min @ NS32CG821-20. 15 ns Min @ NS32CG821-25 = T4 - CTTL to TSO Inactive  $= T_{cp} - \#TSO_{ia}$ = 100 ns - 12 ns = 88 ns @ 10 MHz = 66 ns - 10 ns = 56 ns @ 15 MHz **CWAIT**: Setup for Wait States, before T3re #tCWs. 20 ns Min @ 10 MHz & 15 MHz for NS32CG16 = T1 + T2 - (Time in T1 until  $\overline{CS}$ Asserted + CS to WAIT Asserted)  $= 2T_{cp} - (\#T_{AHv} + t_{Bpal} + $311)$ = 200 ns - (40 ns + 15 ns + 26 ns) = 119 ns @ 10 MHz = 133 ns - (30 ns + 15 ns + 22 ns) = 66 ns @ 15 MHz **CWAIT**: Hold, after T3re #tCWh. 5 ns Min @ 10 MHz & 15 MHz for NS32CG16 = T3re to WAIT Negated = \$17 Min = 7 ns @ NS32CG821-20 = 7 ns @ NS32CG821-25 **CWAIT**: Setup for Termination of Access #tCWs, 20 ns Min @ 10 MHz & 15 MHz for NS32CG16 = T3 - CLK to WAIT Negated = T<sub>cp</sub> - \$17 Max = 100 ns - 39 ns = 61 ns @ 10 MHz NS32CG821-20 Part = 66 ns - 39 ns = 27 ns @ 15 MHz NS32CG821-20 Part

#### DRAM SPECIFIC TIMING WHEN USING THE NS32CG16 @ 10 MHz

Since systems and DRAM times vary, the user is encouraged to change the following equations to match their system requirements. Timing has been supplied for systems with 0 or 1 wait states. The times assume worst case load. As such, the time will improve with lower circuit loads.

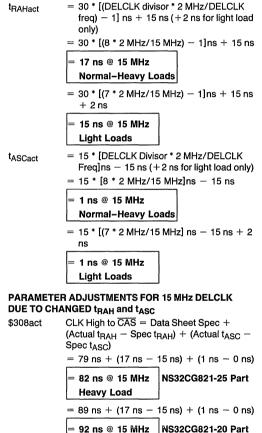


#### DRAM SPECIFIC TIMING WHEN USING THE NS32CG16 @ 15 MHz

The input DELCLK controls the internal delay line and should be a multiple of 2 MHz. Since DELCLK is 15 MHz (when directly connected to CTTL) and is not a multiple of 2 MHz,  $t_{RAH}$  and  $t_{ASC}$  will vary from the programmed times according to the equations listed below.

In addition, please note the following pertaining to the timing equations:

- 1. Times for  $t_{\rm RAH}$  and  $t_{\rm ASC}$  at light loads are specified 2 ns longer than for normal-heavy loads. (See data sheet specifications.)
- 2. Light load is defined as 4 banks of four x 4 DRAMs
- When using normal-heavy loads at 15 MHz a DELCLK divisor of 8 is used and when using light loads at 15 MHz a DELCLK divisor of 7 is used.



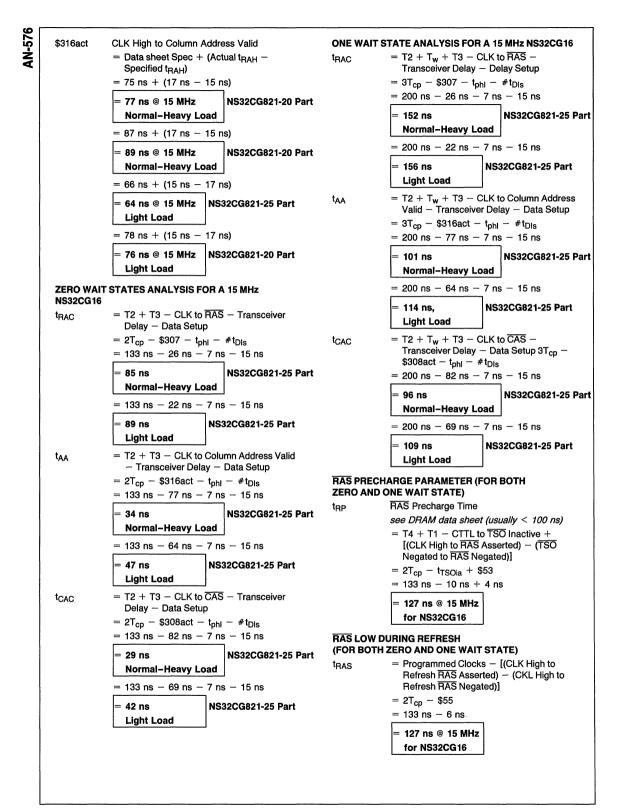
Heavy Load = 72 ns + (15 ns - 17 ns) + (1 ns - 2 ns)

= 69 ns @ 15 MHz NS32CG821-25 Part Light Load

= 81 ns + (15 ns - 17 ns) + (1 ns - 2 ns)

= 78 ns @ 15 MHz NS32CG821-20 Part Light Load





| ogramming Bits* |              |                                                                                      |  |  |
|-----------------|--------------|--------------------------------------------------------------------------------------|--|--|
| Bit             | Value        | Description                                                                          |  |  |
| R1, R0          | 1, 0         | $\overline{RAS}$ Low during Refresh = 2T<br>RAS Precharge Time = 2T                  |  |  |
| R3, R2          | 0, 0<br>1, 1 | No Wait States during Non-Delayed Access<br>One Wait State during Non-Delayed Access |  |  |
| R5, R4          | 0, 0         | No Wait States during Burst                                                          |  |  |
| R6              | User Defined | Add Wait States with WAITIN                                                          |  |  |
| R9              | User Defined | Staggered or all RAS Refresh                                                         |  |  |
| C0, C1, C2      | **           | Divisor for DELCLK                                                                   |  |  |
| C3              | ***          | Time between Refreshes                                                               |  |  |
| C6, C5, C4      | User Defined | Depends on User's DRAM Configurations                                                |  |  |
| C7              | 1            | Choose t <sub>ASC</sub> = 0 ns                                                       |  |  |
| C8              | 1            | Choose t <sub>RAH</sub> = 15 ns                                                      |  |  |
| C9              | 1            | Delay CAS for Write Accesses                                                         |  |  |
| B0              | 1            | Address Latches are Fall Through                                                     |  |  |

\* ECASO, B1, and R7 must be programmed low and R8 must be programmed high for operation of chip.

\*\*Choose C2, C1, C0 =

1, 0, 1 for NS32CG16 @ 10 MHz

0, 1, 0 for NS32CG16 @ 15 MHz, w/Heavy Load

0, 1, 1 for NS32CG16 @ 15 MHz, w/Light Load

\*\*\* Choose C3 =

0 for NS32CGG16 @ 10 MHz

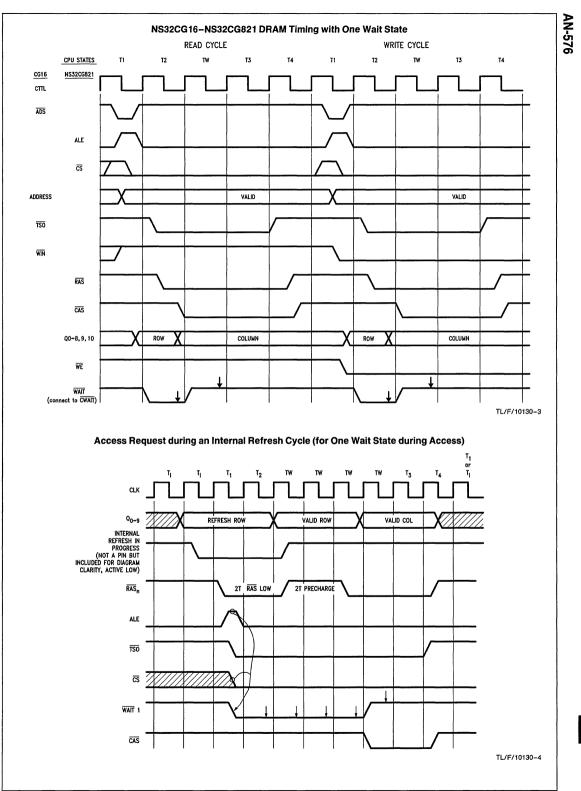
1 for NS32CG16 @ 15 MHz Normal-Heavy Load

0 for NS32CG16 @ 15 MHz Light Load

#### NS32CG16-NS32CG821 Dram Timing for 0 Wait States READ CYCLE WRITE CYCLE CPU STATES T1 T2 T3 T4 T1 T2 T3 **T4** CG16 NS32CG821 CTTL ADS ALE cs ADDRESS VALID VALID TSO WIN RAS CAS QO-8, 9, 10 ROW COLUMN ROW COLUMN X WE T WAIT (connect to CWAIT) DATA (DRAM) READ DATA WRITE DATA

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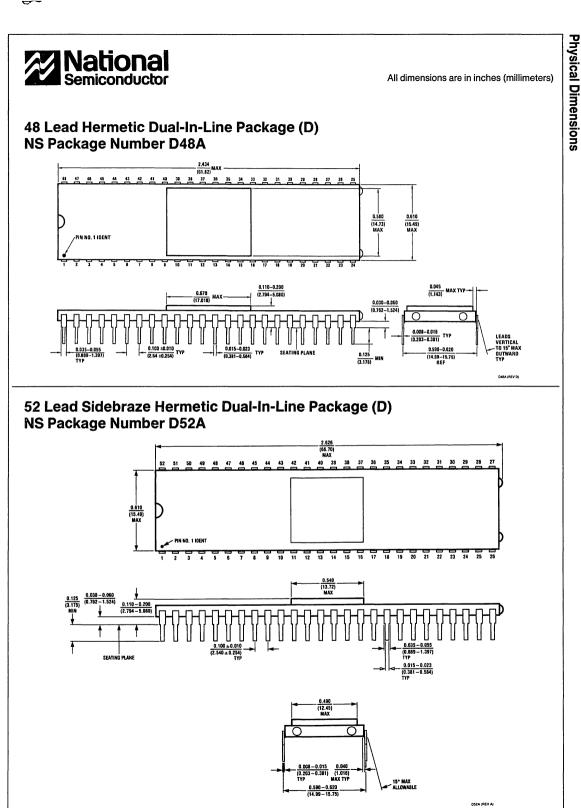
Section 6 Physical Dimensions/ Appendices

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## **Section 6 Contents**

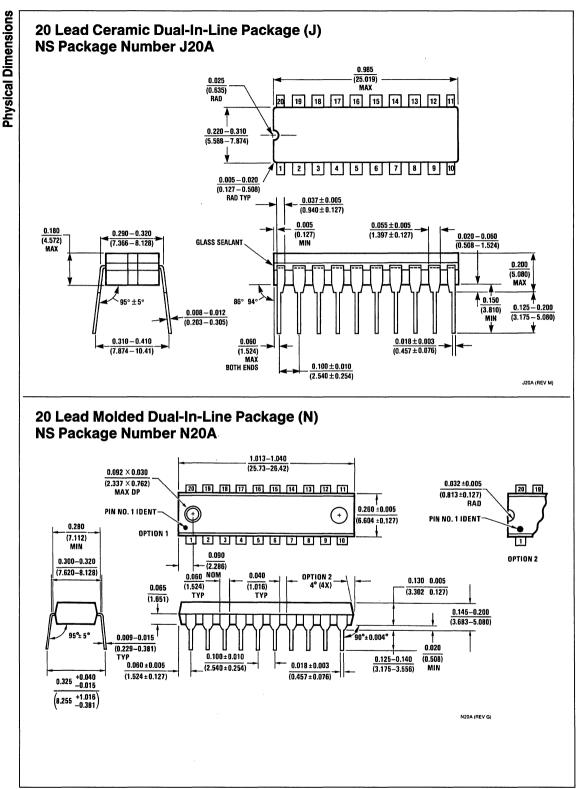
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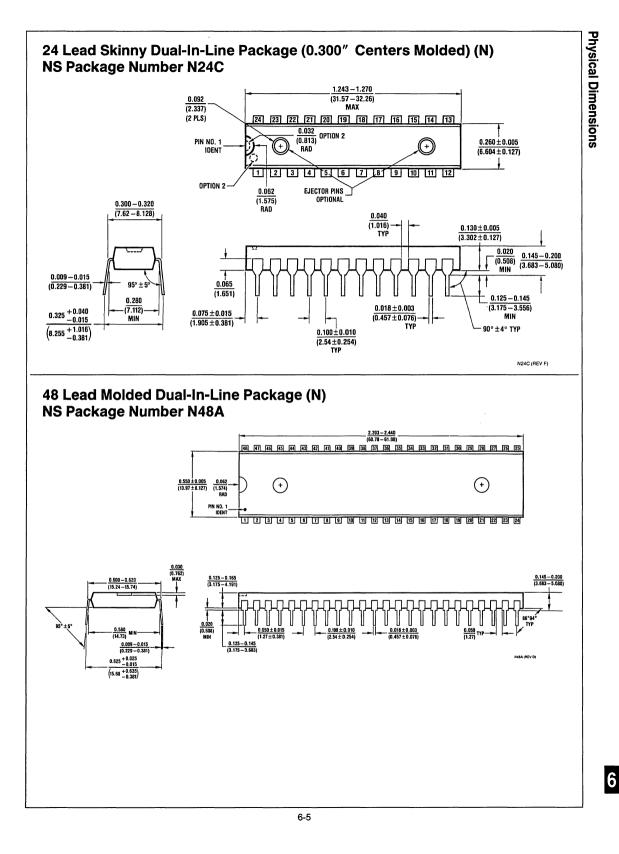


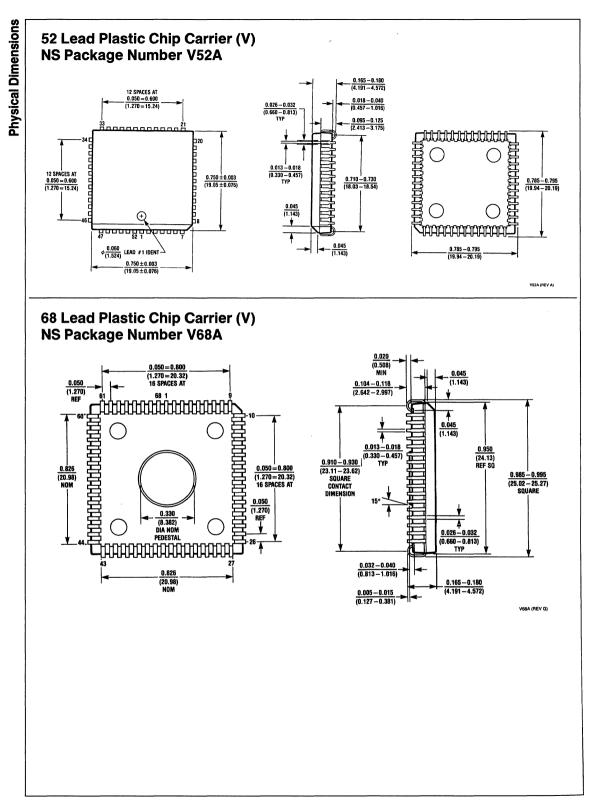
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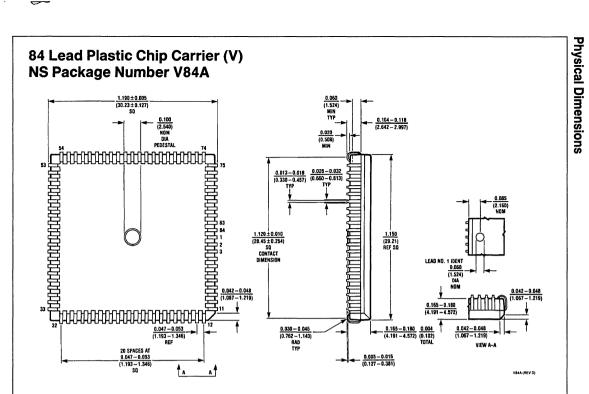
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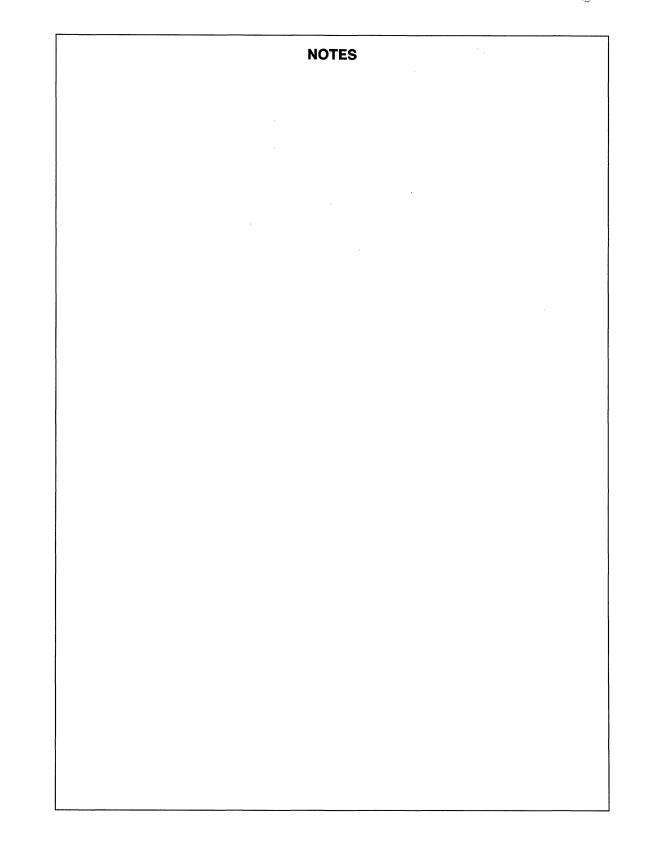
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